

Cyclone V Device Handbook

Volume 1: Device Interfaces and Integration

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Logic Array Blocks and Adaptive Logic Modules in Cyclone V Devices

1

2013.05.06

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This chapter describes the features of the logic array block (LAB) in the Cyclone® V core fabric.

The LAB is composed of basic building blocks known as adaptive logic modules (ALMs) that you can configure to implement logic functions, arithmetic functions, and register functions.

You can use a quarter of the available LABs in the Cyclone V devices as a memory LAB (MLAB).

The Quartus® II software and other supported third-party synthesis tools, in conjunction with parameterized functions such as the library of parameterized modules (LPM), automatically choose the appropriate mode for common functions such as counters, adders, subtractors, and arithmetic functions.

This chapter contains the following sections:

- LAB
- ALM Operating Modes

Related Information

[Cyclone V Device Handbook: Known Issues](#)

Lists the planned updates to the *Cyclone V Device Handbook* chapters.

LAB

The LABs are configurable logic blocks that consist of a group of logic resources. Each LAB contains dedicated logic for driving control signals to its ALMs.

MLAB is a superset of the LAB and includes all the LAB features.

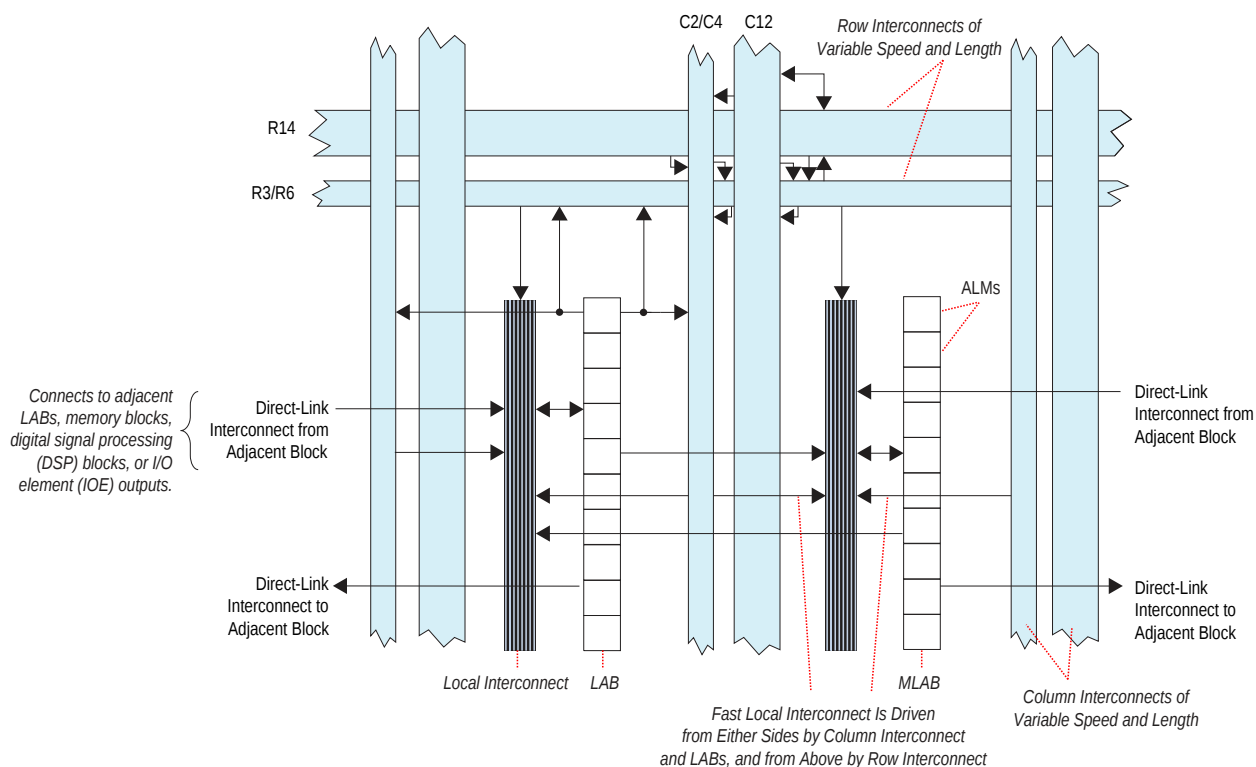
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Figure 1-1: LAB Structure and Interconnects Overview in Cyclone V Devices

This figure shows an overview of the Cyclone V LAB and MLAB structure with the LAB interconnects.

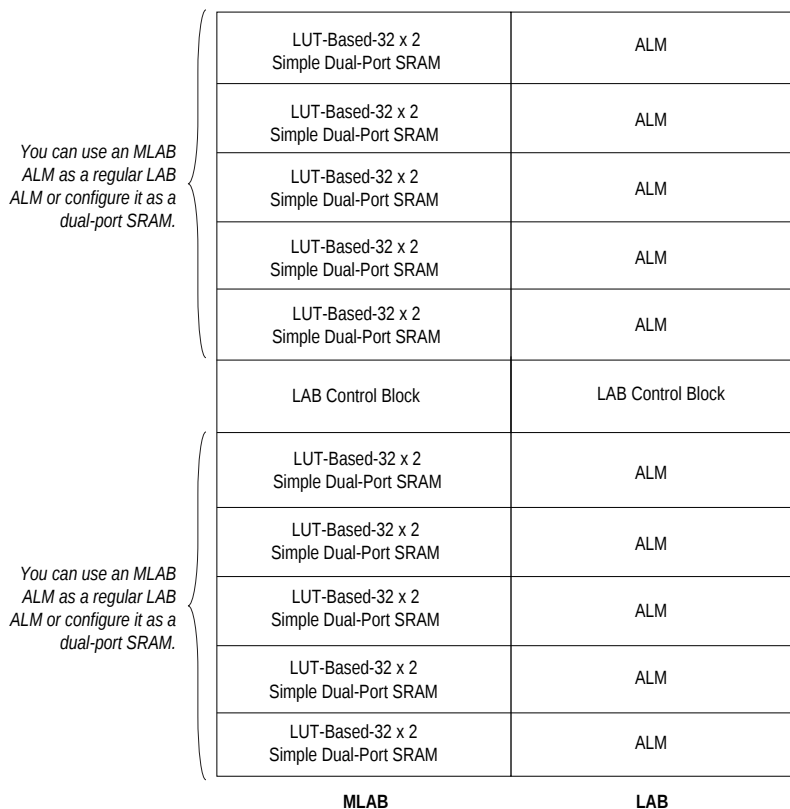


MLAB

Each MLAB supports a maximum of 640 bits of simple dual-port SRAM.

You can configure each ALM in an MLAB as a 32 x 2 memory block, resulting in a configuration of 32 x 20 simple dual-port SRAM block.

Figure 1-2: LAB and MLAB Structure for Cyclone V Devices



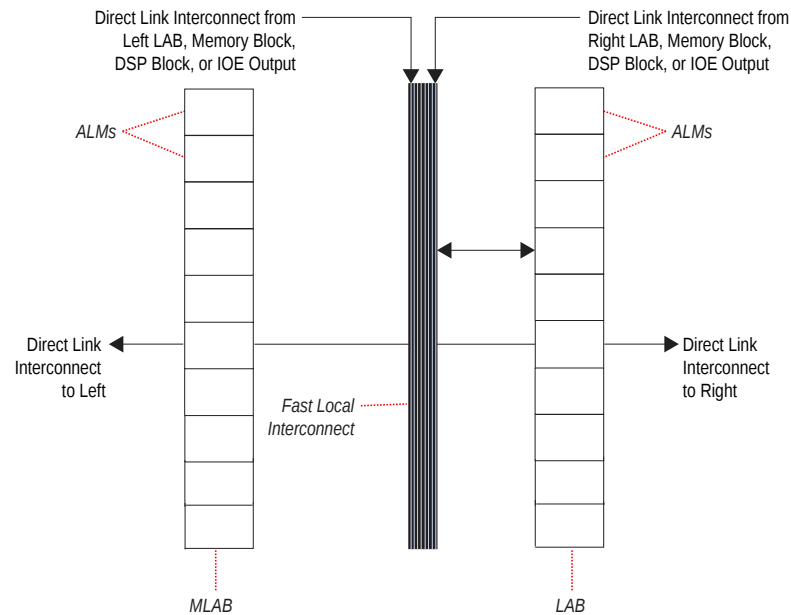
Local and Direct Link Interconnects

Each LAB can drive 30 ALMs through fast-local and direct-link interconnects. Ten ALMs are in any given LAB and ten ALMs are in each of the adjacent LABs.

The local interconnect can drive ALMs in the same LAB using column and row interconnects and ALM outputs in the same LAB.

Neighboring LABs, MLABs, M10K blocks, or digital signal processing (DSP) blocks from the left or right can also drive the LAB's local interconnect using the direct link connection.

The direct link connection feature minimizes the use of row and column interconnects, providing higher performance and flexibility.

Figure 1-3: LAB Fast Local and Direct Link Interconnects for Cyclone V Devices

LAB Control Signals

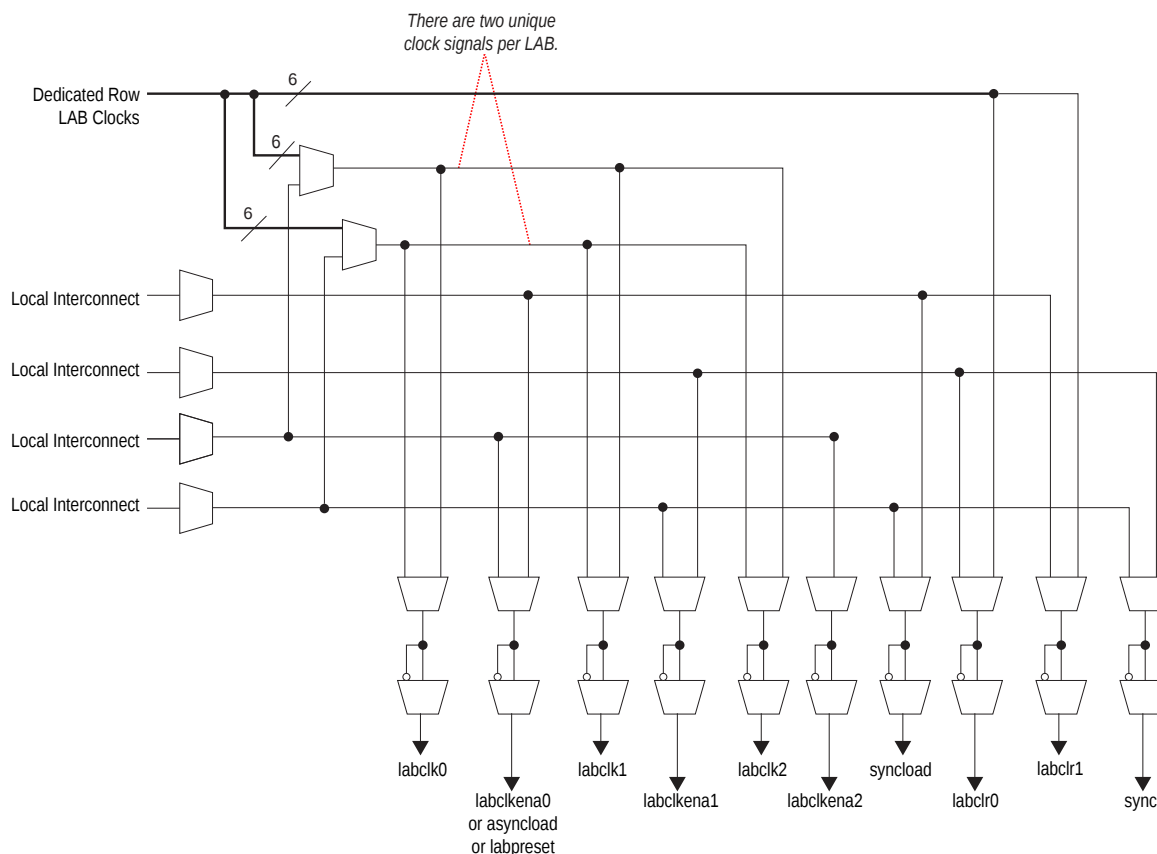
Each LAB contains dedicated logic for driving the control signals to its ALMs, and has two unique clock sources and three clock enable signals.

The LAB control block generates up to three clocks using the two clock sources and three clock enable signals. Each clock and the clock enable signals are linked.

De-asserting the clock enable signal turns off the corresponding LAB-wide clock.

Figure 1-4: LAB-Wide Control Signals for Cyclone V Devices

This figure shows the clock sources and clock enable signals in a LAB.



ALM Resources

One ALM contains four programmable registers. Each register has the following ports:

- Data
- Clock
- Synchronous and asynchronous clear
- Synchronous load

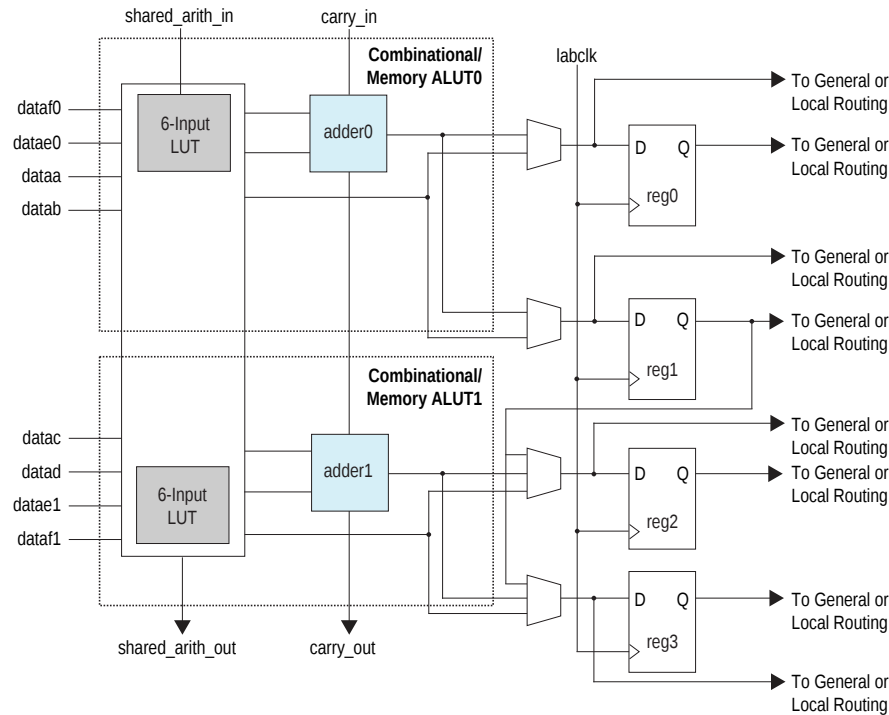
Global signals, general-purpose I/O (GPIO) pins, or any internal logic can drive the clock and clear control signals of an ALM register.

GPIO pins or internal logic drives the clock enable signal.

For combinational functions, the registers are bypassed and the output of the look-up table (LUT) drives directly to the outputs of an ALM.

Note: The Quartus II software automatically configures the ALMs for optimized performance.

Figure 1-5: ALM High-Level Block Diagram for Cyclone V Devices

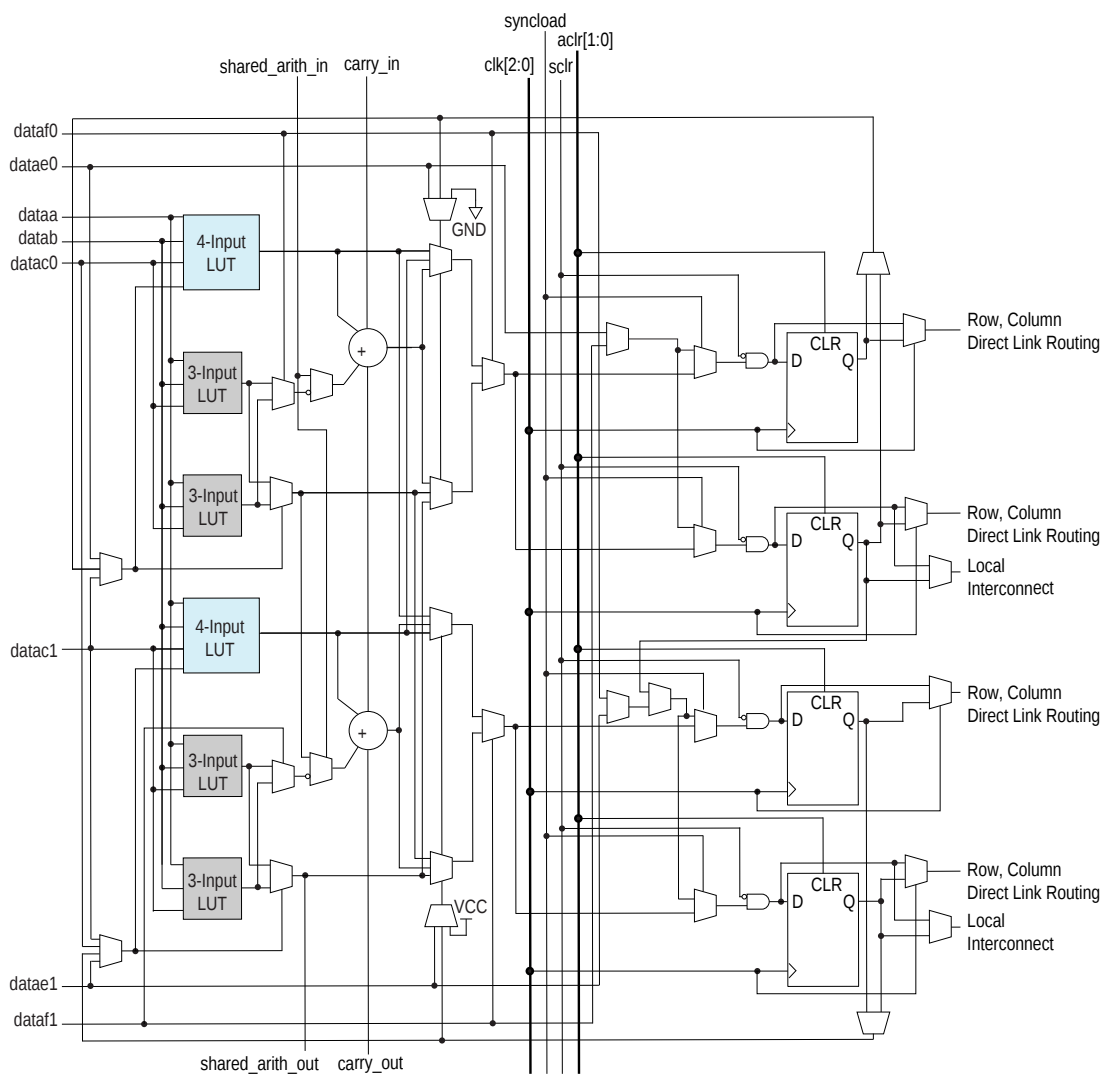


ALM Output

The general routing outputs in each ALM drive the local, row, and column routing resources. Two ALM outputs can drive column, row, or direct link routing connections, and one of these ALM outputs can also drive local interconnect resources.

The LUT, adder, or register output can drive the ALM outputs. The LUT or adder can drive one output while the register drives another output.

Register packing improves device utilization by allowing unrelated register and combinational logic to be packed into a single ALM. Another mechanism to improve fitting is to allow the register output to feed back into the look-up table (LUT) of the same ALM so that the register is packed with its own fan-out LUT. The ALM can also drive out registered and unregistered versions of the LUT or adder output.

Figure 1-6: ALM Connection Details for Cyclone V Devices

ALM Operating Modes

The Cyclone V ALM operates in any of the following modes:

- Normal mode
- Extended LUT mode
- Arithmetic mode
- Shared arithmetic mode

Normal Mode

Normal mode allows two functions to be implemented in one Cyclone V ALM, or a single function of up to six inputs.

Up to eight data inputs from the LAB local interconnect are inputs to the combinational logic.

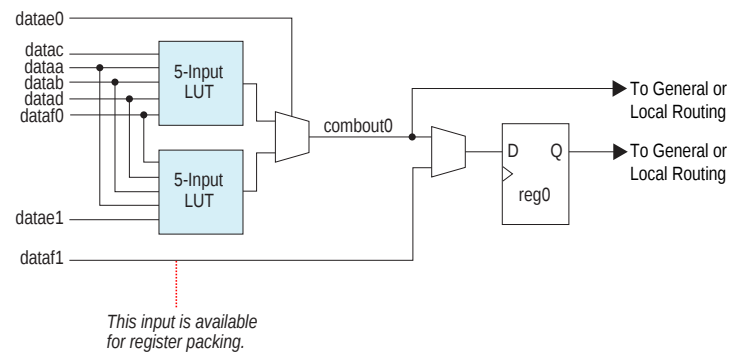
The ALM can support certain combinations of completely independent functions and various combinations of functions that have common inputs.

Extended LUT Mode

In this mode, if the 7-input function is unregistered, the unused eighth input is available for register packing.

Functions that fit into the template, as shown in the following figure, often appear in designs as “if-else” statements in Verilog HDL or VHDL code.

Figure 1-7: Template for Supported 7-Input Functions in Extended LUT Mode for Cyclone V Devices



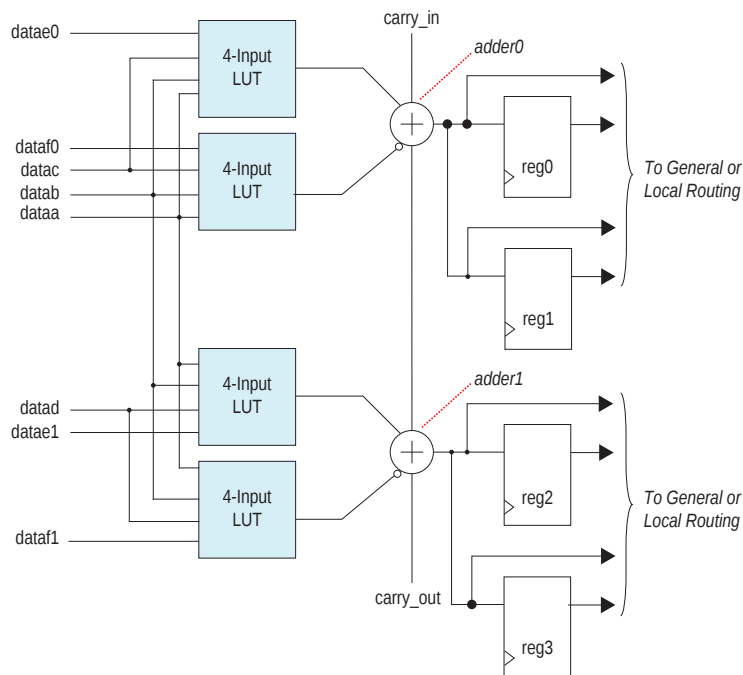
Arithmetic Mode

The ALM in arithmetic mode uses two sets of two 4-input LUTs along with two dedicated full adders.

The dedicated adders allow the LUTs to perform pre-adder logic; therefore, each adder can add the output of two 4-input functions.

The ALM supports simultaneous use of the adder's carry output along with combinational logic outputs. The adder output is ignored in this operation.

Using the adder with the combinational logic output provides resource savings of up to 50% for functions that can use this mode.

Figure 1-8: ALM in Arithmetic Mode for Cyclone V Devices

Carry Chain

The carry chain provides a fast carry function between the dedicated adders in arithmetic or shared arithmetic mode.

The two-bit carry select feature in Cyclone V devices halves the propagation delay of carry chains within the ALM. Carry chains can begin in either the first ALM or the fifth ALM in a LAB. The final carry-out signal is routed to an ALM, where it is fed to local, row, or column interconnects.

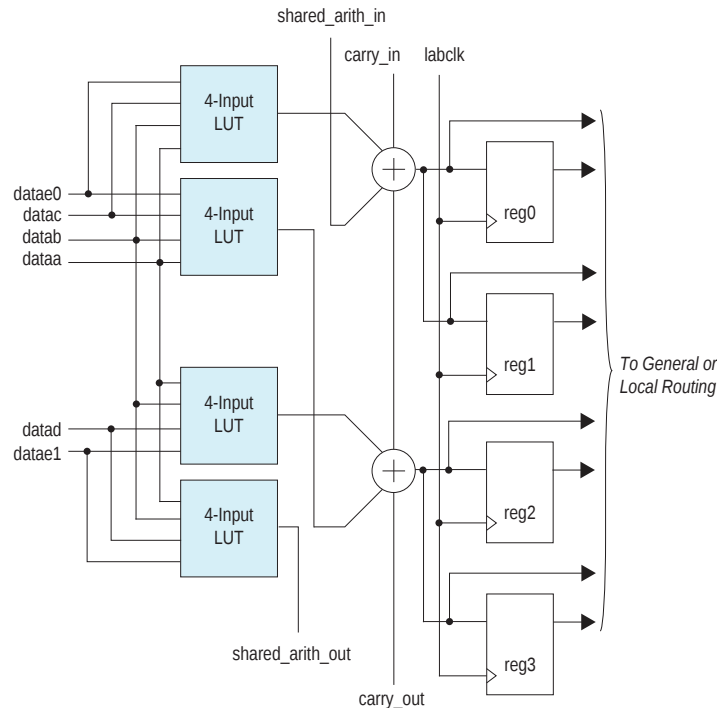
To avoid routing congestion in one small area of the device when a high fan-in arithmetic function is implemented, the LAB can support carry chains that only use either the top half or bottom half of the LAB before connecting to the next LAB. This leaves the other half of the ALMs in the LAB available for implementing narrower fan-in functions in normal mode. Carry chains that use the top five ALMs in the first LAB carry into the top half of the ALMs in the next LAB in the column. Carry chains that use the bottom five ALMs in the first LAB carry into the bottom half of the ALMs in the next LAB within the column. You can bypass the top-half of the LAB columns and bottom-half of the MLAB columns.

The Quartus II Compiler creates carry chains longer than 20 ALMs (10 ALMs in arithmetic or shared arithmetic mode) by linking LABs together automatically. For enhanced fitting, a long carry chain runs vertically, allowing fast horizontal connections to the TriMatrix memory and DSP blocks. A carry chain can continue as far as a full column.

Shared Arithmetic Mode

The ALM in shared arithmetic mode can implement a 3-input add in the ALM.

This mode configures the ALM with four 4-input LUTs. Each LUT either computes the sum of three inputs or the carry of three inputs. The output of the carry computation is fed to the next adder using a dedicated connection called the shared arithmetic chain.

Figure 1-9: ALM in Shared Arithmetic Mode for Cyclone V Devices

Shared Arithmetic Chain

The shared arithmetic chain available in enhanced arithmetic mode allows the ALM to implement a 3-input adder. This significantly reduces the resources necessary to implement large adder trees or correlator functions.

The shared arithmetic chain can begin in either the first or sixth ALM in a LAB.

Similar to carry chains, the top and bottom half of the shared arithmetic chains in alternate LAB columns can be bypassed. This capability allows the shared arithmetic chain to cascade through half of the ALMs in an LAB while leaving the other half available for narrower fan-in functionality. In every LAB, the column is top-half bypassable; while in MLAB, columns are bottom-half bypassable.

The Quartus II Compiler creates shared arithmetic chains longer than 20 ALMs (10 ALMs in arithmetic or shared arithmetic mode) by linking LABs together automatically. To enhance fitting, a long shared arithmetic chain runs vertically, allowing fast horizontal connections to the TriMatrix memory and DSP blocks. A shared arithmetic chain can continue as far as a full column.

Document Revision History

Date	Version	Changes
May 2013	2013.05.06	<ul style="list-style-type: none"> Added link to the known document issues in the Knowledge Base. Removed register chain outputs information in ALM output section. Removed <code>reg_chain_in</code> and <code>reg_chain_out</code> ports in ALM high-level block diagram and ALM connection details diagram.

Date	Version	Changes
December 2012	2012.12.28	Reorganized content and updated template.
June 2012	2.0	Updated for the Quartus II software v12.0 release: <ul style="list-style-type: none">• Restructured chapter.• Updated Figure 1–6.
November 2011	1.1	Minor text edits.
October 2011	1.0	Initial release.

2013.05.06

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The embedded memory blocks in the devices are flexible and designed to provide an optimal amount of small- and large-sized memory arrays to fit your design requirements.

Related Information

Cyclone V Device Handbook: Known Issues

Lists the planned updates to the *Cyclone V Device Handbook* chapters.

Types of Embedded Memory

The Cyclone V devices contain two types of memory blocks:

- 10 Kb M10K blocks—blocks of dedicated memory resources. The M10K blocks are ideal for larger memory arrays while still providing a large number of independent ports.
- 640 bit memory logic array blocks (MLABs)—enhanced memory blocks that are configured from dual-purpose logic array blocks (LABs). The MLABs are ideal for wide and shallow memory arrays. The MLABs are optimized for implementation of shift registers for digital signal processing (DSP) applications, wide shallow FIFO buffers, and filter delay lines. Each MLAB is made up of ten adaptive logic modules (ALMs). In the Cyclone V devices, you can configure these ALMs as ten 32 x 2 blocks, giving you one 32 x 20 simple dual-port SRAM block per MLAB.

Embedded Memory Capacity in Cyclone V Devices

Table 2-1: Embedded Memory Capacity and Distribution in Cyclone V Devices

Variant	Member Code	M10K		MLAB		Total RAM Bit (Kb)
		Block	RAM Bit (Kb)	Block	RAM Bit (Kb)	
Cyclone V E	A2	176	1,760	314	196	1,956
	A4	308	3,080	485	303	3,383
	A5	446	4,460	679	424	4,884
	A7	686	6,860	1338	836	7,696
	A9	1,220	12,200	2748	1,717	13,917

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Variant	Member Code	M10K		MLAB		Total RAM Bit (Kb)
		Block	RAM Bit (Kb)	Block	RAM Bit (Kb)	
Cyclone V GX	C3	119	1,190	255	159	1,349
	C4	250	2,500	472	295	2,795
	C5	446	4,460	679	424	4,884
	C7	686	6,860	1338	836	7,696
	C9	1,220	12,200	2748	1,717	13,917
Cyclone V GT	D5	446	4,460	679	424	4,884
	D7	686	6,860	1338	836	7,696
	D9	1,220	12,200	2748	1,717	13,917
Cyclone V SE	A2	140	1,400	221	138	1,538
	A4	270	2,700	370	231	2,460
	A5	397	3,970	768	480	4,450
	A6	557	5,570	994	621	5,761
Cyclone V SX	C2	140	1,400	221	138	1,538
	C4	270	2,700	370	231	2,460
	C5	397	3,970	768	480	4,450
	C6	557	5,570	994	621	5,761
Cyclone V ST	D5	397	3,970	768	480	4,450
	D6	557	5,570	994	621	5,761

Embedded Memory Design Guidelines for Cyclone V Devices

There are several considerations that require your attention to ensure the success of your designs. Unless noted otherwise, these design guidelines apply to all variants of this device family.

Guideline: Consider the Memory Block Selection

The Quartus II software automatically partitions the user-defined memory into the memory blocks based on your design's speed and size constraints. For example, the Quartus II software may spread out the memory across multiple available memory blocks to increase the performance of the design.

To assign the memory to a specific block size manually, use the RAM megafunction in the MegaWizard™ Plug-In Manager.

For the memory logic array blocks (MLAB), you can implement single-port SRAM through emulation using the Quartus II software. Emulation results in minimal additional use of logic resources.

Because of the dual-purpose architecture of the MLAB, only data input and output registers are available in the block. The MLABs gain read address registers from the ALMs. However, the write address and read data registers are internal to the MLABs.

Guideline: Implement External Conflict Resolution

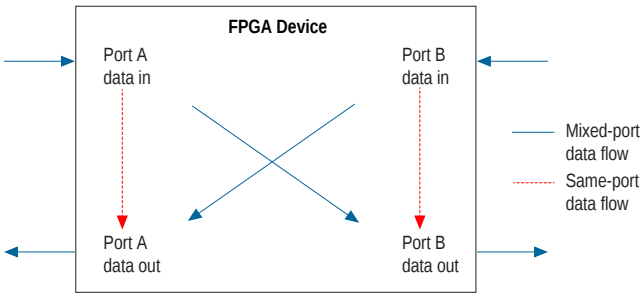
In the true dual-port RAM mode, you can perform two write operations to the same memory location. However, the memory blocks do not have internal conflict resolution circuitry. To avoid unknown data being written to the address, implement external conflict resolution logic to the memory block.

Guideline: Customize Read-During-Write Behavior

Customize the read-during-write behavior of the memory blocks to suit your design requirements.

Figure 2-1: Read-During-Write Data Flow

This figure shows the difference between the two types of read-during-write operations available—same port and mixed port.



Same-Port Read-During-Write Mode

The same-port read-during-write mode applies to a single-port RAM or the same port of a true dual-port RAM.

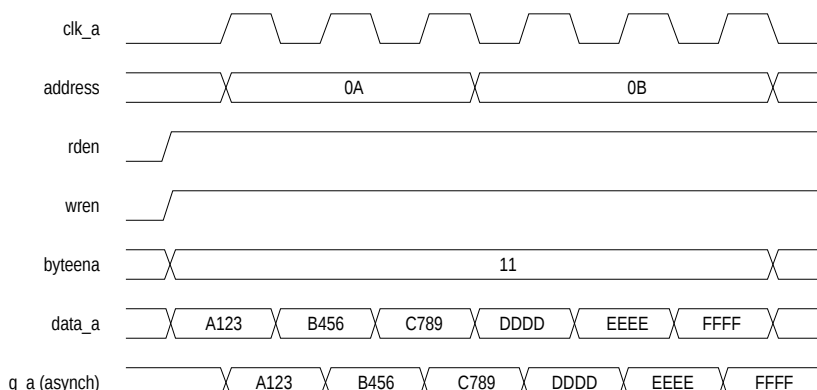
Table 2-2: Output Modes for Embedded Memory Blocks in Same-Port Read-During-Write Mode

This table lists the available output modes if you select the embedded memory blocks in the same-port read-during-write mode.

Output Mode	Memory Type	Description
"new data" (flow-through)	M10K	The new data is available on the rising edge of the same clock cycle on which the new data is written.
"don't care"	M10K, MLAB	The RAM outputs "don't care" values for a read-during-write operation.

Figure 2-2: Same-Port Read-During-Write: New Data Mode

This figure shows sample functional waveforms of same-port read-during-write behavior in the “new data” mode.



Mixed-Port Read-During-Write Mode

The mixed-port read-during-write mode applies to simple and true dual-port RAM modes where two ports perform read and write operations on the same memory address using the same clock—one port reading from the address, and the other port writing to it.

Table 2-3: Output Modes for RAM in Mixed-Port Read-During-Write Mode

Output Mode	Memory Type	Description
"new data"	MLAB	<p>A read-during-write operation to different ports causes the MLAB registered output to reflect the “new data” on the next rising edge after the data is written to the MLAB memory.</p> <p>This mode is available only if the output is registered.</p>
"old data"	M10K, MLAB	<p>A read-during-write operation to different ports causes the RAM output to reflect the “old data” value at the particular address.</p> <p>For MLAB, this mode is available only if the output is registered.</p>
"don't care"	M10K, MLAB	<p>The RAM outputs “don’t care” or “unknown” value.</p> <ul style="list-style-type: none"> For M10K memory, the Quartus II software does not analyze the timing between write and read operations. For MLAB, the Quartus II software analyzes the timing between write and read operations by default. To disable this behavior, turn on the Do not analyze the timing between write and read operation. Metastability issues are prevented by never writing and reading at the same address at the same time option.

Output Mode	Memory Type	Description
"constrained don't care"	MLAB	The RAM outputs "don't care" or "unknown" value. The Quartus II software analyzes the timing between write and read operations in the MLAB.

Figure 2-3: Mixed-Port Read-During-Write: New Data Mode

This figure shows a sample functional waveform of mixed-port read-during-write behavior for the “new data” mode.

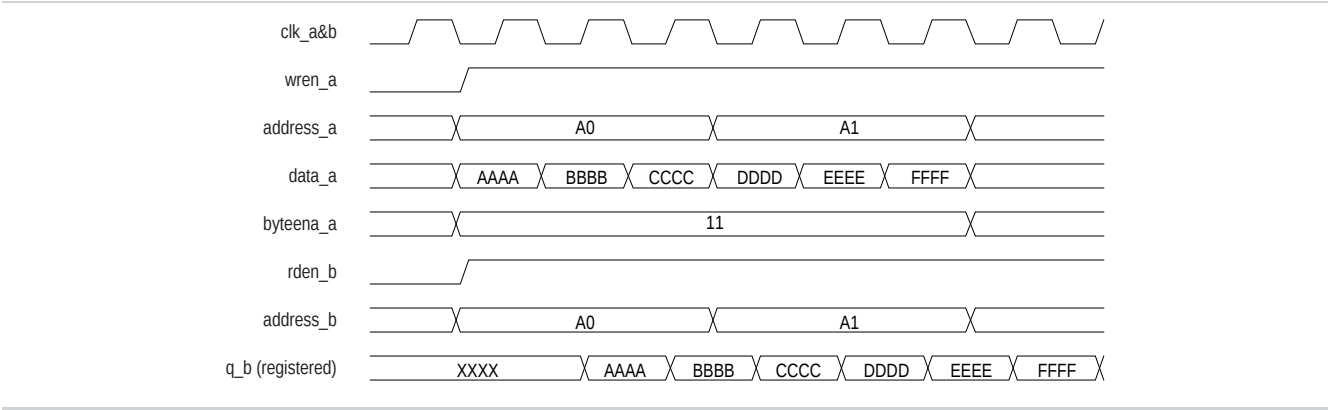


Figure 2-4: Mixed-Port Read-During-Write: Old Data Mode

This figure shows a sample functional waveform of mixed-port read-during-write behavior for the “old data” mode.

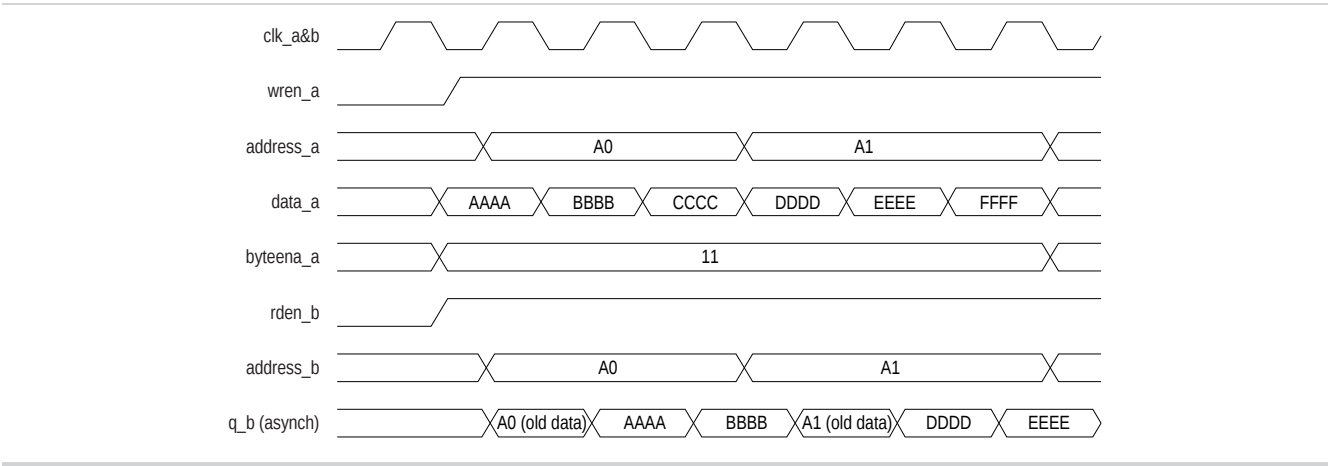
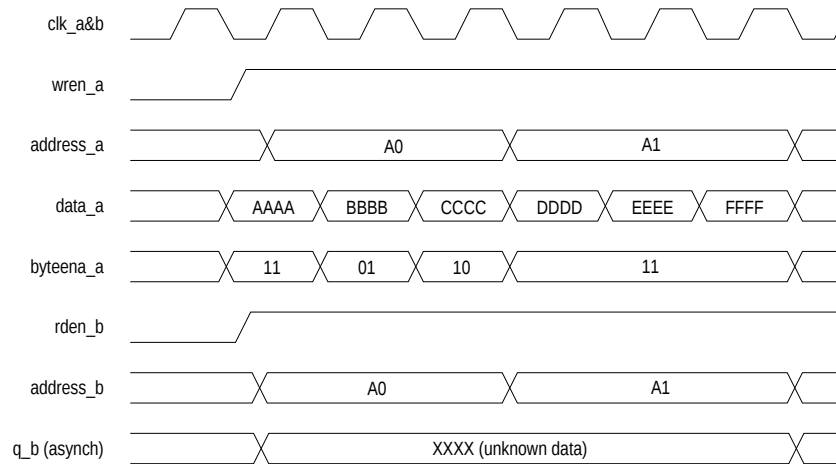


Figure 2-5: Mixed-Port Read-During-Write: Don't Care or Constrained Don't Care Mode

This figure shows a sample functional waveform of mixed-port read-during-write behavior for the “don't care” or “constrained don't care” mode.



In the dual-port RAM mode, the mixed-port read-during-write operation is supported if the input registers have the same clock. The output value during the operation is “unknown.”

Related Information

[Internal Memory \(RAM and ROM\) User Guide](#)

Provides more information about the RAM megafunction that controls the read-during-write behavior.

Guideline: Consider Power-Up State and Memory Initialization

Consider the power up state of the different types of memory blocks if you are designing logic that evaluates the initial power-up values, as listed in the following table.

Table 2-4: Initial Power-Up Values of Embedded Memory Blocks

Memory Type	Output Registers	Power Up Value
MLAB	Used	Zero (cleared)
	Bypassed	Read memory contents
M10K	Used	Zero (cleared)
	Bypassed	Zero (cleared)

By default, the Quartus II software initializes the RAM cells in Cyclone V devices to zero unless you specify a **.mif**.

All memory blocks support initialization with a **.mif**. You can create **.mif** files in the Quartus II software and specify their use with the RAM megafunction when you instantiate a memory in your design. Even if a memory is pre-initialized (for example, using a **.mif**), it still powers up with its output cleared.

Related Information

- [Internal Memory \(RAM and ROM\) User Guide](#)
Provides more information about .mif files.
- [Quartus II Handbook](#)
Provides more information about .mif files.

Guideline: Control Clocking to Reduce Power Consumption

Reduce AC power consumption in your design by controlling the clocking of each memory block:

- Use the read-enable signal to ensure that read operations occur only when necessary. If your design does not require read-during-write, you can reduce your power consumption by deasserting the read-enable signal during write operations, or during the period when no memory operations occur.
- Use the Quartus II software to automatically place any unused memory blocks in low-power mode to reduce static power.

Embedded Memory Features

Table 2-5: Memory Features in Cyclone V Devices

This table summarizes the features supported by the embedded memory blocks.

Features	M10K	MLAB
Maximum operating frequency	315 MHz	420 MHz
Total RAM bits (including parity bits)	10,240	640
Parity bits	Supported	Supported
Byte enable	Supported	Supported
Packed mode	Supported	—
Address clock enable	Supported	Supported
Simple dual-port mixed width	Supported	—
True dual-port mixed width	Supported	—
FIFO buffer mixed width	Supported	—
Memory Initialization File (.mif)	Supported	Supported
Mixed-clock mode	Supported	Supported
Fully synchronous memory	Supported	Supported
Asynchronous memory	—	Only for flow-through read memory operations.

Features	M10K	MLAB
Power-up state	Output ports are cleared.	<ul style="list-style-type: none"> Registered output ports—Cleared. Unregistered output ports—Read memory contents.
Asynchronous clears	Output registers and output latches	Output registers and output latches
Write/read operation triggering	Rising clock edges	Rising clock edges
Same-port read-during-write	Output ports set to "new data" or "don't care". (The "don't care" mode applies only for the single-port RAM mode).	Output ports set to "don't care".
Mixed-port read-during-write	Output ports set to "old data" or "don't care".	Output ports set to "old data", "new data", "don't care", or "constrained don't care".
ECC support	Soft IP support using the Quartus II software.	Soft IP support using the Quartus II software.

Related Information**[Internal Memory \(RAM and ROM\) User Guide](#)**

Provides more information about the embedded memory features.

Embedded Memory Configurations

Table 2-6: Supported Embedded Memory Block Configurations for Cyclone V Devices

This table lists the maximum configurations supported for the embedded memory blocks. The information is applicable only to the single-port RAM and ROM modes.

Memory Block	Depth (bits)	Programmable Width
MLAB	32	x16, x18, or x20
M10K	256	x40 or x32
	512	x20 or x16
	1K	x10 or x8
	2K	x5 or x4
	4K	x2
	8K	x1

Mixed-Width Port Configurations

The mixed-width port configuration is supported in the simple dual-port RAM and true dual-port RAM memory modes.

Note: MLABs do not support mixed-width port configurations.

Related Information

[Internal Memory \(RAM and ROM\) User Guide](#)

Provides more information about dual-port mixed width support.

M10K Blocks Mixed-Width Configurations

Table 2-7: M10K Block Mixed-Width Configurations in Simple Dual-Port RAM Mode

Read Port	Write Port									
	8K x 1	4K x 2	2K x 4	2K x 5	1K x 8	1k x 10	512 x 16	512 x 20	256 x 32	256 x 40
8K x 1	Yes	Yes	Yes	—	Yes	—	Yes	—	Yes	—
4K x 2	Yes	Yes	Yes	—	Yes	—	Yes	—	Yes	—
2K x 4	Yes	Yes	Yes	—	Yes	—	Yes	—	Yes	—
2K x 5	—	—	—	Yes	—	Yes	—	Yes	—	Yes
1K x 8	Yes	Yes	Yes	—	Yes	—	Yes	—	Yes	—
1K x 10	—	—	—	Yes	—	Yes	—	Yes	—	Yes
512 x 16	Yes	Yes	Yes	—	Yes	—	Yes	—	Yes	—
512 x 20	—	—	—	Yes	—	Yes	—	Yes	—	Yes
256 x 32	Yes	Yes	Yes	—	Yes	—	Yes	—	Yes	—
256 x 40	—	—	—	Yes	—	Yes	—	Yes	—	Yes

Table 2-8: M10K Block Mixed-Width Configurations in True Dual-Port Mode

Port B	Port A							
	8K x 1	4K x 2	2K x 4	2K x 5	1K x 8	1K x 10	512 x 16	512 x 20
8K x 1	Yes	Yes	Yes	—	Yes	—	Yes	—
4K x 2	Yes	Yes	Yes	—	Yes	—	Yes	—
2K x 4	Yes	Yes	Yes	—	Yes	—	Yes	—
2K x 5	—	—	—	Yes	—	Yes	—	Yes
1K x 8	Yes	Yes	Yes	—	Yes	—	Yes	—
1K x 10	—	—	—	Yes	—	Yes	—	Yes
512 x 16	Yes	Yes	Yes	—	Yes	—	Yes	—

Port B	Port A							
	8K x 1	4K x 2	2K x 4	2K x 5	1K x 8	1K x 10	512 x 16	512 x 20
512 x 20	—	—	—	Yes	—	Yes	—	Yes

Embedded Memory Modes

Caution: To avoid corrupting the memory contents, do not violate the setup or hold time on any of the memory block input registers during read or write operations. This is applicable if you use the memory blocks in single-port RAM, simple dual-port RAM, true dual-port RAM, or ROM mode.

Table 2-9: Memory Modes Supported in the Embedded Memory Blocks

This table lists and describes the memory modes that are supported in the Cyclone V embedded memory blocks.

Memory Mode	M10K Support	MLAB Support	Description
Single-port RAM	Yes	Yes	<p>You can perform only one read or one write operation at a time.</p> <p>Use the read enable port to control the RAM output ports behavior during a write operation:</p> <ul style="list-style-type: none"> To retain the previous values that are held during the most recent active read enable—create a read-enable port and perform the write operation with the read enable port deasserted. To show the new data being written, the old data at that address, or a "Don't Care" value when read-during-write occurs at the same address location—do not create a read-enable signal, or activate the read enable during a write operation.
Simple dual-port RAM	Yes	Yes	You can simultaneously perform one read and one write operations to different locations where the write operation happens on port A and the read operation happens on port B.
True dual-port RAM	Yes	—	You can perform any combination of two port operations: two reads, two writes, or one read and one write at two different clock frequencies.
Shift-register	Yes	Yes	<p>You can use the memory blocks as a shift-register block to save logic cells and routing resources.</p> <p>This is useful in DSP applications that require local data storage such as finite impulse response (FIR) filters, pseudo-random number generators, multi-channel filtering, and auto- and cross-correlation functions. Traditionally, the local data storage is implemented with standard flip-flops that exhaust many logic cells for large shift registers.</p> <p>The input data width (w), the length of the taps (m), and the number of taps (n) determine the size of a shift register ($w \times m \times n$). You can cascade memory blocks to implement larger shift registers.</p>

Memory Mode	M10K Support	MLAB Support	Description
ROM	Yes	Yes	<p>You can use the memory blocks as ROM.</p> <ul style="list-style-type: none"> Initialize the ROM contents of the memory blocks using a .mif or .hex. The address lines of the ROM are registered on M10K blocks but can be unregistered on MLABs. The outputs can be registered or unregistered. The output registers can be asynchronously cleared. The ROM read operation is identical to the read operation in the single-port RAM configuration.
FIFO	Yes	Yes	<p>You can use the memory blocks as FIFO buffers. Use the SCFIFO and DCFIFO megafunctions to implement single- and dual-clock asynchronous FIFO buffers in your design.</p> <p>For designs with many small and shallow FIFO buffers, the MLABs are ideal for the FIFO mode. However, the MLABs do not support mixed-width FIFO mode.</p>

Related Information

- [Internal Memory \(RAM and ROM\) User Guide](#)
Provides more information memory modes.
- [RAM-Based Shift Register \(ALTSHIFT_TAPS\) Megafunction User Guide](#)
Provides more information about implementing the shift register mode.
- [SCFIFO and DCFIFO Megafunctions User Guide](#)
Provides more information about implementing FIFO buffers.

Embedded Memory Clocking Modes

This section describes the clocking modes for the Cyclone V memory blocks.

Caution: To avoid corrupting the memory contents, do not violate the setup or hold time on any of the memory block input registers during read or write operations.

Clocking Modes for Each Memory Mode

Table 2-10: Memory Blocks Clocking Modes Supported for Each Memory Mode

Clocking Mode	Memory Mode				
	Single-Port	Simple Dual-Port	True Dual-Port	ROM	FIFO
Single clock mode	Yes	Yes	Yes	Yes	Yes
Read/write clock mode	—	Yes	—	—	Yes

Clocking Mode	Memory Mode				
	Single-Port	Simple Dual-Port	True Dual-Port	ROM	FIFO
Input/output clock mode	Yes	Yes	Yes	Yes	—
Independent clock mode	—	—	Yes	Yes	—

Note: The clock enable signals are not supported for write address, byte enable, and data input registers on MLAB blocks.

Single Clock Mode

In the single clock mode, a single clock, together with a clock enable, controls all registers of the memory block.

Read/Write Clock Mode

In the read/write clock mode, a separate clock is available for each read and write port. A read clock controls the data-output, read-address, and read-enable registers. A write clock controls the data-input, write-address, write-enable, and byte enable registers.

Input/Output Clock Mode

In input/output clock mode, a separate clock is available for each input and output port. An input clock controls all registers related to the data input to the memory block including data, address, byte enables, read enables, and write enables. An output clock controls the data output registers.

Independent Clock Mode

In the independent clock mode, a separate clock is available for each port (A and B). Clock A controls all registers on the port A side; clock B controls all registers on the port B side.

Note: You can create independent clock enable for different input and output registers to control the shut down of a particular register for power saving purposes. From the parameter editor, click **More Options** (beside the clock enable option) to set the available independent clock enable that you prefer.

Asynchronous Clears in Clocking Modes

In all clocking modes, asynchronous clears are available only for output latches and output registers. For the independent clock mode, this is applicable on both ports.

Output Read Data in Simultaneous Read/Write

If you perform a simultaneous read/write to the same address location using the read/write clock mode, the output read data is unknown. If you require the output read data to be a known value, use single-clock or input/output clock mode and select the appropriate read-during-write behavior in the MegaWizard™ Plug-In Manager.

Independent Clock Enables in Clocking Modes

Independent clock enables are supported in the following clocking modes:

- Read/write clock mode—supported for both the read and write clocks.
- Independent clock mode—supported for the registers of both ports.

To save power, you can control the shut down of a particular register using the clock enables.

Related Information

Guideline: Control Clocking to Reduce Power Consumption on page 2-7

Parity Bit in Memory Blocks

Table 2-11: Parity Bit Support for the Embedded Memory Blocks

This table describes the parity bit support for the memory blocks.

M10K	MLAB
<ul style="list-style-type: none">• The parity bit is the fifth bit associated with each 4 data bits in data widths of 5, 10, 20, and 40 (bits 4, 9, 14, 19, 24, 29, 34, and 39).• In non-parity data widths, the parity bits are skipped during read or write operations.• Parity function is not performed on the parity bit.	<ul style="list-style-type: none">• The parity bit is the ninth bit associated with each byte.• The ninth bit can store a parity bit or serve as an additional bit.• Parity function is not performed on the parity bit.

Byte Enable in Embedded Memory Blocks

The embedded memory blocks support byte enable controls:

- The byte enable controls mask the input data so that only specific bytes of data are written. The unwritten bytes retain the values written previously.
- The write enable (`wren`) signal, together with the byte enable (`byteena`) signal, control the write operations on the RAM blocks. By default, the `byteena` signal is high (enabled) and only the `wren` signal controls the writing.
- The byte enable registers do not have a `clear` port.
- If you are using parity bits, on the M10K blocks, the byte enable function controls 8 data bits and 2 parity bits; on the MLABs, the byte enable function controls all 10 bits in the widest mode.
- The MSB and LSB of the `byteena` signal correspond to the MSB and LSB of the data bus, respectively.
- The byte enables are active high.

Byte Enable Controls in Memory Blocks

Table 2-12: `byteena` Controls in x20 Data Width

<code>byteena[1:0]</code>	Data Bits Written	
11 (default)	[19 : 10]	[9 : 0]
10	[19 : 10]	—

byteena[1:0]	Data Bits Written	
01	—	[9 : 0]

Table 2-13: byteena Controls in x40 Data Width

byteena[3:0]	Data Bits Written			
1111 (default)	[39 : 30]	[29 : 20]	[19 : 10]	[9 : 0]
1000	[39 : 30]	—	—	—
0100	—	[29 : 20]	—	—
0010	—	—	[19 : 10]	—
0001	—	—	—	[9 : 0]

Data Byte Output

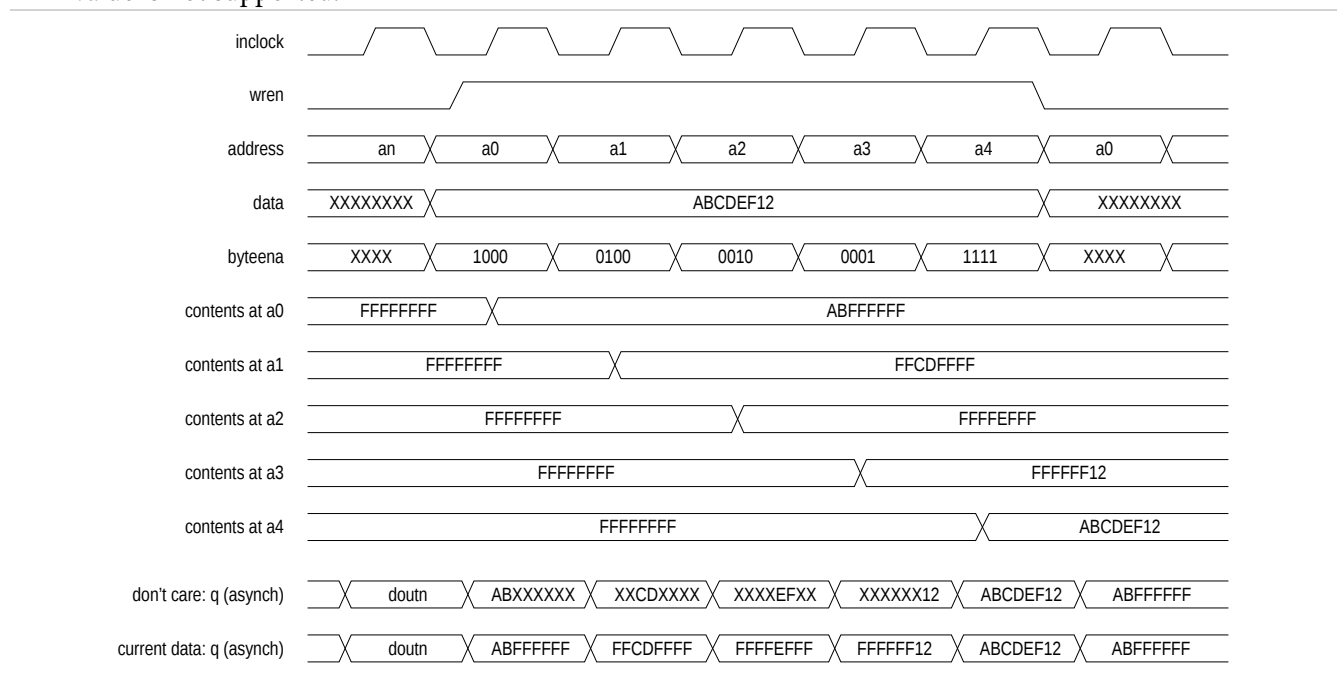
In M10K blocks, the corresponding masked data byte output appears as a “don’t care” value.

In MLABs, when you de-assert a byte-enable bit during a write cycle, the corresponding data byte output appears as either a “don’t care” value or the current data at that location. You can control the output value for the masked byte in the MLABs by using the Quartus II software.

RAM Blocks Operations

Figure 2-6: Byte Enable Functional Waveform

This figure shows how the wren and byteena signals control the operations of the RAM blocks. For the M10K blocks, the write-masked data byte output appears as a “don’t care” value because the “current data” value is not supported.



Memory Blocks Packed Mode Support

The M10K memory blocks support packed mode.

The packed mode feature packs two independent single-port RAM blocks into one memory block. The Quartus II software automatically implements packed mode where appropriate by placing the physical RAM block in true dual-port mode and using the MSB of the address to distinguish between the two logical RAM blocks. The size of each independent single-port RAM must not exceed half of the target block size.

Memory Blocks Address Clock Enable Support

The embedded memory blocks support address clock enable, which holds the previous address value for as long as the signal is enabled (`addressstall = 1`). When the memory blocks are configured in dual-port mode, each port has its own independent address clock enable. The default value for the address clock enable signal is low (disabled).

Figure 2-7: Address Clock Enable

This figure shows an address clock enable block diagram. The address clock enable is referred to by the port name `addressstall`.

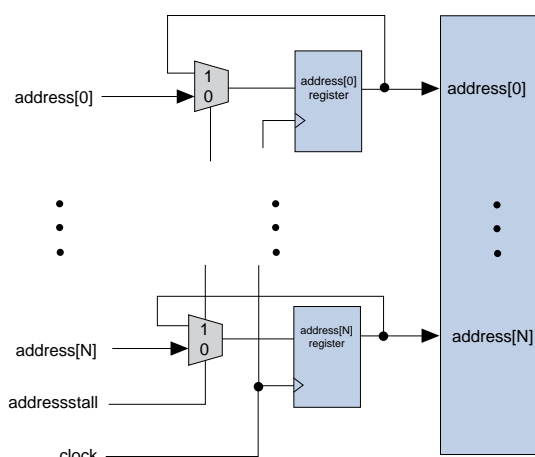


Figure 2-8: Address Clock Enable During Read Cycle Waveform

This figure shows the address clock enable waveform during the read cycle.

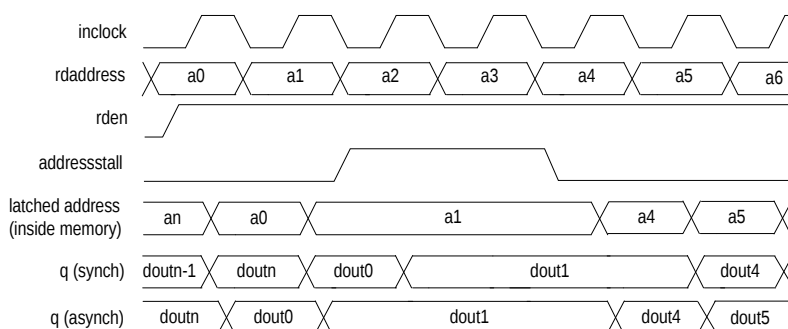
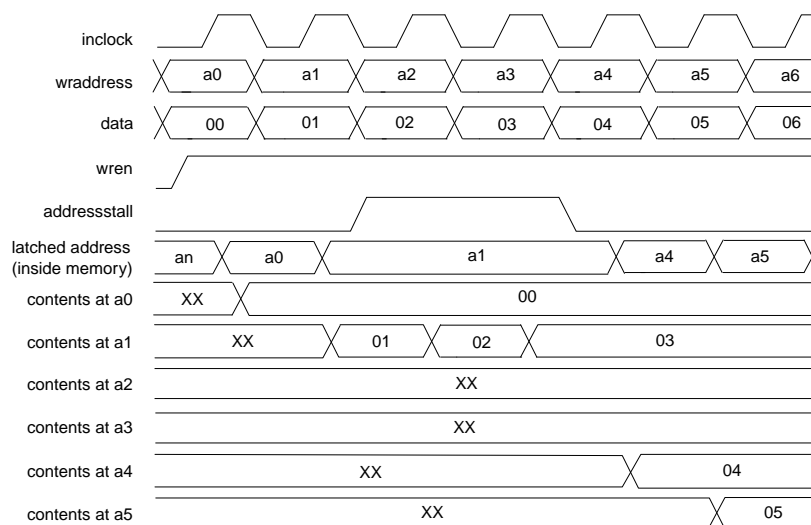


Figure 2-9: Address Clock Enable During the Write Cycle Waveform

This figure shows the address clock enable waveform during the write cycle.



Document Revision History

Date	Version	Changes
May 2013	2013.05.06	<ul style="list-style-type: none"> Moved all links to the Related Information section of respective topics for easy reference. Added link to the known document issues in the Knowledge Base. Updated the maximum operating frequency of the MLAB. Corrected the description about the "don't care" output mode for RAM in mixed-port read-during-write. Reorganized the structure of the supported memory configurations topics (single-port and mixed-width dual-port) to improve clarity about maximum data widths supported for each configuration. Added a description to the table listing the maximum embedded memory configurations to clarify that the information applies only to the single port or ROM mode. Removed the topic about mixed-width configurations for MLABs and added a note to clarify that MLABs do not support mixed-width configuration.

Date	Version	Changes
December 2012	2012.12.28	<ul style="list-style-type: none">• Reorganized content and updated template.• Added memory capacity information from the <i>Cyclone V Device Overview</i> for easy reference.• Moved information about supported memory block configurations into its own table.• Added short descriptions of each clocking mode.• Added topic about the packed mode support.• Added topic about the address clock enable support.
June 2012	2.0	<ul style="list-style-type: none">• Restructured the chapter.• Updated the “Memory Modes”, “Clocking Modes”, and “Design Considerations” sections.• Updated Table 2–1.• Added the “Parity Bit” and “Byte Enable” sections.• Moved the memory capacity information to the <i>Cyclone V Device Overview</i>.
October 2011	1.0	Initial release.



2013.05.06

CV-52003



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This chapter describes how the variable-precision digital signal processing (DSP) blocks in Cyclone V devices are optimized to support higher bit precision in high-performance DSP applications.

Related Information

[Cyclone V Device Handbook: Known Issues](#)

Lists the planned updates to the *Cyclone V Device Handbook* chapters.

Features

The Cyclone V variable precision DSP blocks offer the following features:

- High-performance, power-optimized, and fully registered multiplication operations
- 9-bit, 18-bit, and 27-bit word lengths
- Two 18 x 19 complex multiplications
- Built-in addition, subtraction, and dual 64-bit accumulation unit to combine multiplication results
- Cascading 19-bit or 27-bit to form the tap-delay line for filtering applications
- Cascading 64-bit output bus to propagate output results from one block to the next block without external logic support
- Hard pre-adder supported in 19-bit, and 27-bit mode for symmetric filters
- Internal coefficient register bank for filter implementation
- 18-bit and 27-bit systolic finite impulse response (FIR) filters with distributed output adder

Related Information

[Cyclone V Device Overview](#)

Provides more information about the number of multipliers in each Cyclone V device.

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Supported Operational Modes in Cyclone V Devices

Table 3-1: Variable Precision DSP Blocks Operational Modes for Cyclone V Devices

Variable-Precision DSP Block Resource	Operation Mode	Supported Instance	Pre-Adder Support	Coefficient Support	Input Cascade Support ⁽¹⁾	Chainout Support
1 variable precision DSP block	Independent 9 x 9 multiplication	3	No	No	No	No
	Independent 18 x 18 multiplication	2	Yes	Yes	Yes	No
	Independent 18 x 19 multiplication	2	Yes	Yes	Yes	No
	Independent 18 x 25 multiplication	1	Yes	Yes	Yes	Yes
	Independent 20 x 24 multiplication	1	Yes	Yes	Yes	Yes
	Independent 27 x 27 multiplication	1	Yes	Yes	Yes	Yes
	Two 18 x 19 multiplier adder mode	1	Yes	Yes	Yes	Yes
	18 x 18 multiplier adder summed with 36-bit input	1	Yes	No	No	Yes
2 variable precision DSP blocks	Complex 18 x 19 multiplication	1	No	No	Yes	No

⁽¹⁾ When you enable the pre-adder feature, the input cascade support is not available.

Resources

Table 3-2: Number of Multipliers in Cyclone V Devices

The table lists the variable-precision DSP resources by bit precision for each Cyclone V device.

Variant	Member Code	Variable-precision DSP Block	Independent Input and Output Multiplications Operator			18 x 18 Multiplier Adder Mode	18 x 18 Multiplier Adder Summed with 36 bit Input
			9 x 9 Multiplier	18 x 18 Multiplier	27 x 27 Multiplier		
Cyclone V E	A2	25	75	50	25	25	25
	A4	66	198	132	66	66	66
	A5	150	450	300	150	150	150
	A7	156	468	312	156	156	156
	A9	342	1,026	684	342	342	342
Cyclone V GX	C3	51	153	102	51	51	51
	C4	70	210	140	70	70	70
	C5	150	450	300	150	150	150
	C7	156	468	312	156	156	156
	C9	342	1,026	684	342	342	342
Cyclone V GT	D5	150	450	300	150	150	150
	D7	156	468	312	156	156	156
	D9	342	1,026	684	342	342	342
Cyclone V SE	A2	36	108	72	36	36	36
	A4	58	174	116	58	58	58
	A5	87	261	174	87	87	87
	A6	112	336	224	112	112	112
Cyclone V SX	C2	36	108	72	36	36	36
	C4	84	252	168	84	84	84
	C5	87	261	174	87	87	87
	C6	112	336	224	112	112	112
Cyclone V ST	D5	87	261	174	87	87	87
	D6	112	336	224	112	112	112

Design Considerations

You should consider the following elements in your design:

- Operational modes
- Internal coefficient and pre-adder
- Accumulator
- Chainout adder

Operational Modes

The Quartus II software includes megafunctions that you can use to control the operation mode of the multipliers. After entering the parameter settings with the MegaWizard Plug-In Manager, the Quartus II software automatically configures the variable precision DSP block.

Altera provides two methods for implementing various modes of the Cyclone V variable precision DSP block in a design—using the Quartus II DSP megafunction and HDL inferring.

The following Quartus II megafunctions are supported for the Cyclone V variable precision DSP blocks implementation:

- LPM_MULT
- ALTMULT_ADD
- ALTMULT_ACCUM
- ALTMULT_COMPLEX

Related Information

- [Introduction to Megafunction User Guide](#)
- [Integer Arithmetic Megafunctions User Guide](#)
- [Floating-Point Megafunctions User Guide](#)
- [Quartus II Software Help](#)

Internal Coefficient and Pre-Adder

To use the pre-adder feature, all input data and multipliers must have the same clock setting.

The input cascade support is not available when you enable the pre-adder feature.

In both 18-bit and 27-bit modes, you can use the coefficient feature and pre-adder feature independently.

Accumulator

The accumulator in the Cyclone V devices supports double accumulation by enabling the 64-bit double accumulation registers located between the output register bank and the accumulator.

The double accumulation registers are set statically in the programming file.

Chainout Adder

You can use the output chaining path to add results from other DSP blocks.

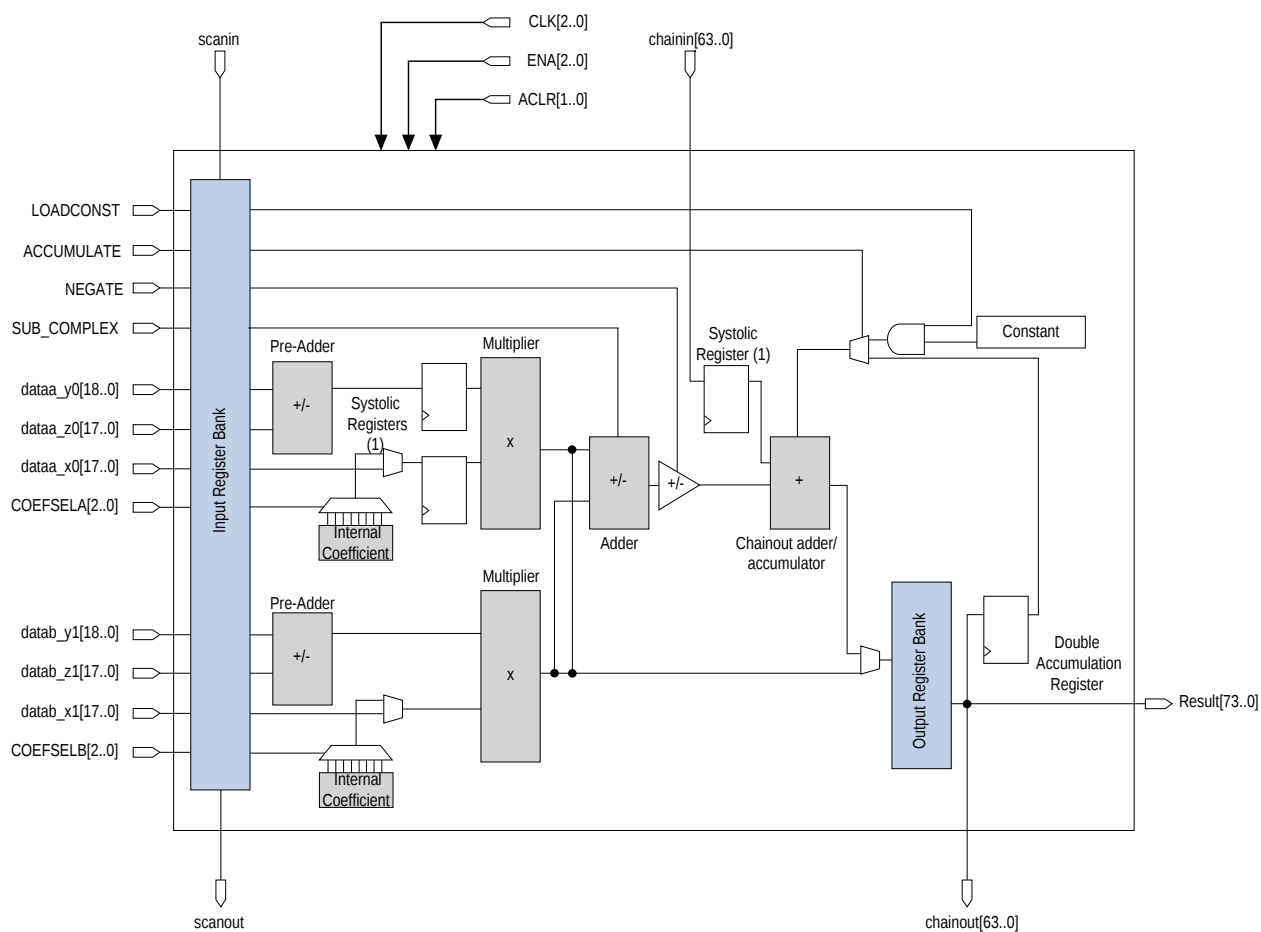
Block Architecture

The Cyclone V variable precision DSP block consists of the following elements:

- Input register bank
- Pre-adder
- Internal coefficient
- Multipliers
- Adder
- Accumulator and chainout adder
- Systolic registers
- Double accumulation register
- Output register bank

If the variable precision DSP block is not configured in systolic FIR mode, both systolic registers are bypassed.

Figure 3-1: Variable Precision DSP Block Architecture for Cyclone V Devices



Note:

1. When enabled, systolic registers are clocked with the same clock source as the output register bank.

Input Register Bank

The input register bank consists of data, dynamic control signals, and two sets of delay registers.

All the registers in the DSP blocks are positive-edge triggered and cleared on power up. Each multiplier operand can feed an input register or a multiplier directly, bypassing the input registers.

The following variable precision DSP block signals control the input registers within the variable precision DSP block:

- `CLK[2..0]`
- `ENA[2..0]`
- `ACLR[0]`

In 18 x 19 mode, you can use the delay registers to balance the latency requirements when you use both the input cascade and chainout features.

The tap-delay line feature allows you to drive the top leg of the multiplier input, `dataa_y0` and `datab_y1` in 18 x 19 mode and `dataa_y0` only in 27 x 27 mode, from the general routing or cascade chain.

Figure 3-2: Input Register of a Variable Precision DSP Block in 18 x 19 Mode for Cyclone V Devices

The figures show the data registers only. Registers for the control signals are not shown.

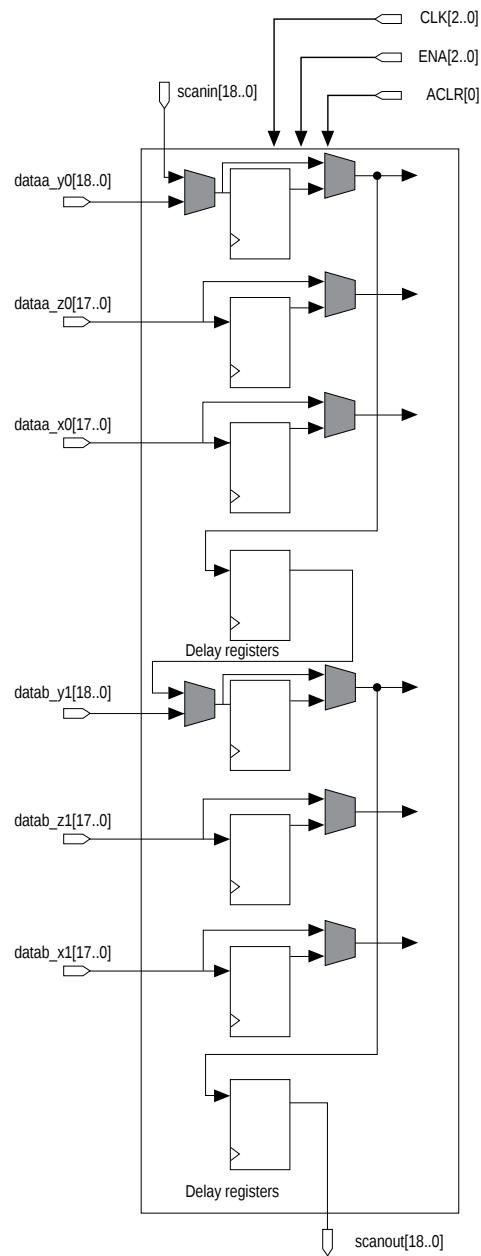
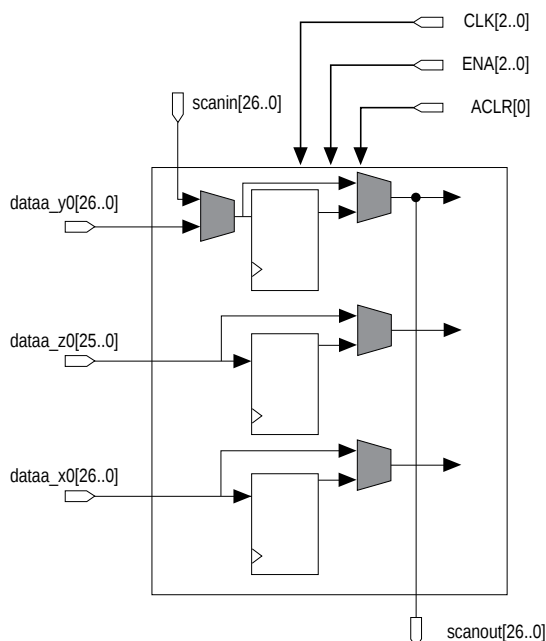


Figure 3-3: Input Register of a Variable Precision DSP Block in 27 x 27 Mode for Cyclone V Devices

The figures show the data registers only. Registers for the control signals are not shown.



Pre-Adder

Cyclone V Devices

Each variable precision DSP block has two 19-bit pre-adders. You can configure these pre-adders in the following configurations:

- Two independent 19-bit pre-adders
- One 27-bit pre-adder

The pre-adder supports both addition and subtraction in the following input configurations:

- 18-bit (signed) addition or subtraction for 18 x 19 mode
- 17-bit (unsigned) addition or subtraction for 18 x 19 mode
- 26-bit addition or subtraction for 27 x 27 mode

Internal Coefficient

The Cyclone V variable precision DSP block has the flexibility of selecting the multiplicand from either the dynamic input or the internal coefficient.

The internal coefficient can support up to eight constant coefficients for the multiplicands in 18-bit and 27-bit modes. When you enable the internal coefficient feature, COEFSELA/COEFSELB are used to control the selection of the coefficient multiplexer.

Multipliers

A single variable precision DSP block can perform many multiplications in parallel, depending on the data width of the multiplier.

There are two multipliers per variable precision DSP block. You can configure these two multipliers in several operational modes:

- One 27 x 27 multiplier
- Two 18 (signed)/(unsigned) x 19 (signed) multipliers
- Three 9 x 9 multipliers

Related Information

[Operational Mode Descriptions](#) on page 3-11

Provides more information about the operational modes of the multipliers.

Adder

You can use the adder in various sizes, depending on the operational mode:

- One 64-bit adder with the 64-bit accumulator
- Two 18 x 19 modes—the adder is divided into two 37-bit adders to produce the full 37-bit result of each independent 18 x 19 multiplication
- Three 9 x 9 modes—you can use the adder as three 18-bit adders to produce three 9 x 9 multiplication results independently

Accumulator and Chainout Adder

The Cyclone V variable precision DSP block supports a 64-bit accumulator and a 64-bit adder.

The following signals can dynamically control the function of the accumulator:

- NEGATE
- LOADCONST
- ACCUMULATE

The accumulator supports double accumulation by enabling the 64-bit double accumulation registers located between the output register bank and the accumulator.

The double accumulation registers are set statically in the programming file.

The accumulator and chainout adder features are not supported in two independent 18 x 19 modes and three independent 9 x 9 modes.

Table 3-3: Accumulator Functions and Dynamic Control Signals

This table lists the dynamic signals settings and description for each function. In this table, X denotes a "don't care" value.

Function	Description	NEGATE	LOADCONST	ACCUMULATE
Zeroing	Disables the accumulator.	0	0	0
Preload	Loads an initial value to the accumulator. Only one bit of the 64-bit preload value can be "1". It can be used as rounding the DSP result to any position of the 64-bit result.	0	1	0

Function	Description	NEGATE	LOADCONST	ACCUMULATE
Accumulation	Adds the current result to the previous accumulate result.	0	X	1
Decimation	This function takes the current result, converts it into two's complement, and adds it to the previous result.	1	X	1

Systolic Registers

There are two systolic registers per variable precision DSP block. If the variable precision DSP block is not configured in systolic FIR mode, both systolic registers are bypassed.

The first set of systolic registers consists of 18-bit and 19-bit registers that are used to register the 18-bit and 19-bit inputs of the upper multiplier, respectively.

The second set of systolic registers are used to delay the chainout output to the next variable precision DSP block.

You must clock all the systolic registers with the same clock source as the output register bank.

Double Accumulation Register

The double accumulation register is an extra register in the feedback path of the accumulator. Enabling the double accumulation register will cause an extra clock cycle delay in the feedback path of the accumulator.

This register has the same CLK, ENA, and ACLR settings as the output register bank.

By enabling this register, you can have two accumulator channels using the same number of variable precision DSP block.

Output Register Bank

The positive edge of the clock signal triggers the 64-bit bypassable output register bank and is cleared after power up.

The following variable precision DSP block signals control the output register per variable precision DSP block:

- CLK[2 . . 0]
- ENA[2 . . 0]
- ACLR[1]

Operational Mode Descriptions

This section describes how you can configure an Cyclone V variable precision DSP block to efficiently support the following operational modes:

- Independent Multiplier Mode
- Independent Complex Multiplier Mode
- Multiplier Adder Sum Mode
- 18 x 18 Multiplication Summed with 36-Bit Input Mode
- Systolic FIR Mode

Independent Multiplier Mode

In independent input and output multiplier mode, the variable precision DSP blocks perform individual multiplication operations for general purpose multipliers.

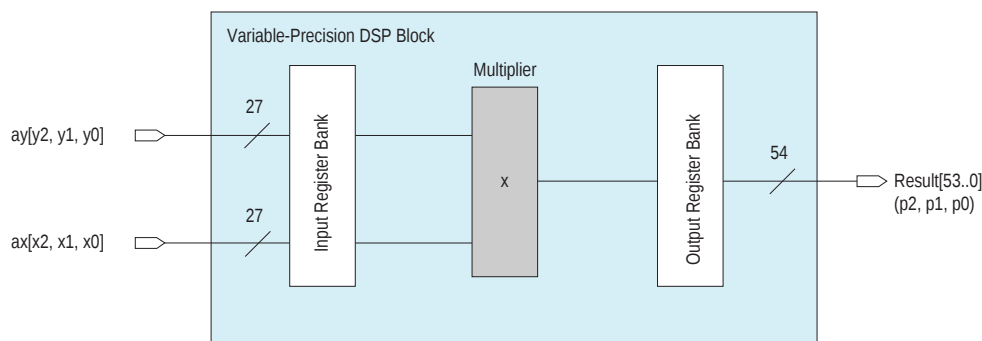
Table 3-4: Variable Precision DSP Block Independent Multiplier Mode Configurations

Configuration	Multipliers per block
9 x 9	3
18 (signed) x 18 (unsigned)	2
18 (unsigned) x 18 (unsigned)	
18 (signed) x 19 (signed)	
18 (unsigned) x 19 (signed)	
18 x 25	1
20 x 24	1
27 x 27	1

9 x 9 Independent Multiplier

Figure 3-4: Three 9 x 9 Independent Multiplier Mode per Variable Precision DSP Block for Cyclone V Devices

Three pairs of data are packed into the `ax` and `ay` ports; `result` contains three 18-bit products.

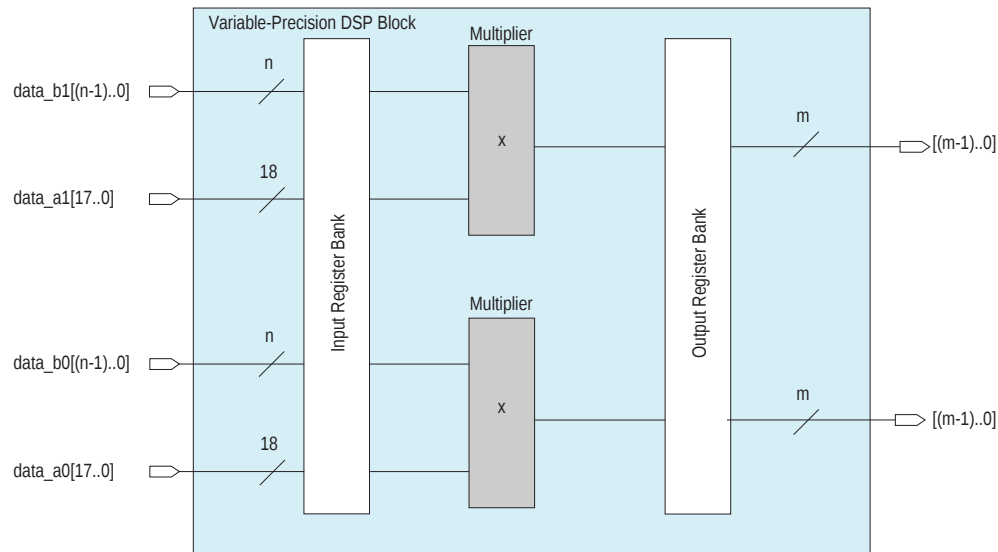


18 x 18 or 18 x 19 Independent Multiplier

Figure 3-5: Two 18 x 18 or 18 x 19 Independent Multiplier Mode per Variable Precision DSP Block for Cyclone V Devices

In this figure, the variables are defined as follows:

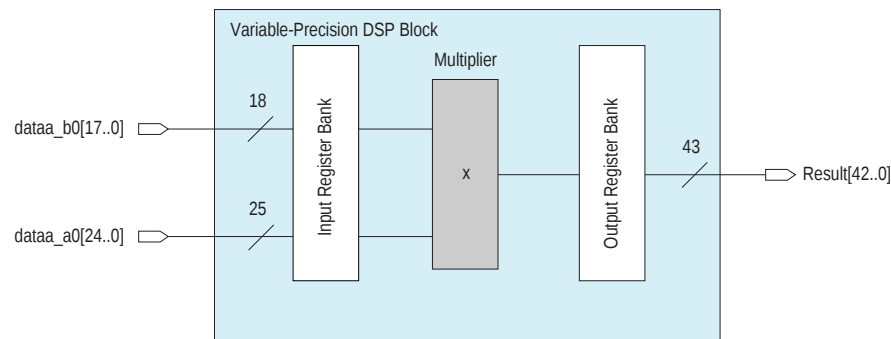
- $n = 19$ and $m = 37$ for 18 x 19 mode
- $n = 18$ and $m = 36$ for 18 x 18 mode



18 x 25 Independent Multiplier

Figure 3-6: One 18 x 25 Independent Multiplier Mode per Variable Precision DSP Block for Cyclone V Devices

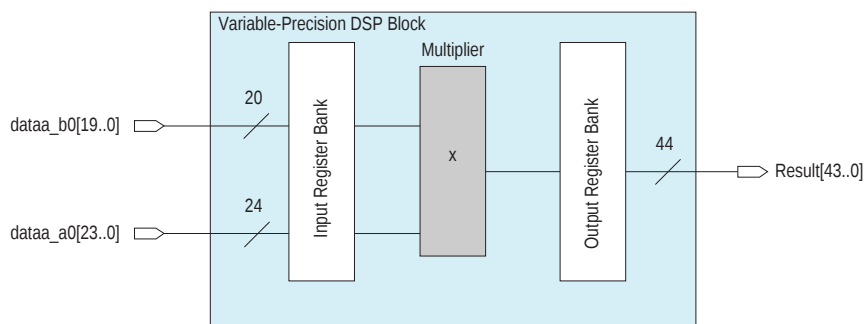
In this mode, the result can be up to 52 bits when combined with a chainout adder or accumulator.



20 x 24 Independent Multiplier

Figure 3-7: One 20 x 24 Independent Multiplier Mode per Variable Precision DSP Block for Cyclone V Devices

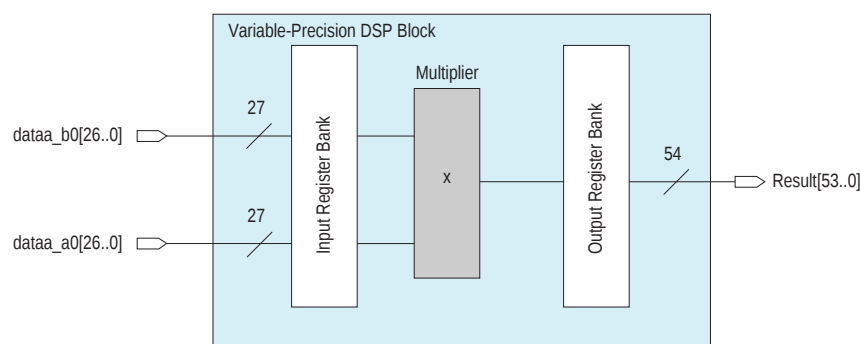
In this mode, the result can be up to 52 bits when combined with a chainout adder or accumulator.



27 x 27 Independent Multiplier

Figure 3-8: One 27 x 27 Independent Multiplier Mode per Variable Precision DSP Block for Cyclone V Devices

In this mode, the result can be up to 64 bits when combined with a chainout adder or accumulator.



Independent Complex Multiplier Mode

The Cyclone V devices support the 18 x 19 complex multiplier mode using two Cyclone V variable-precision DSP blocks.

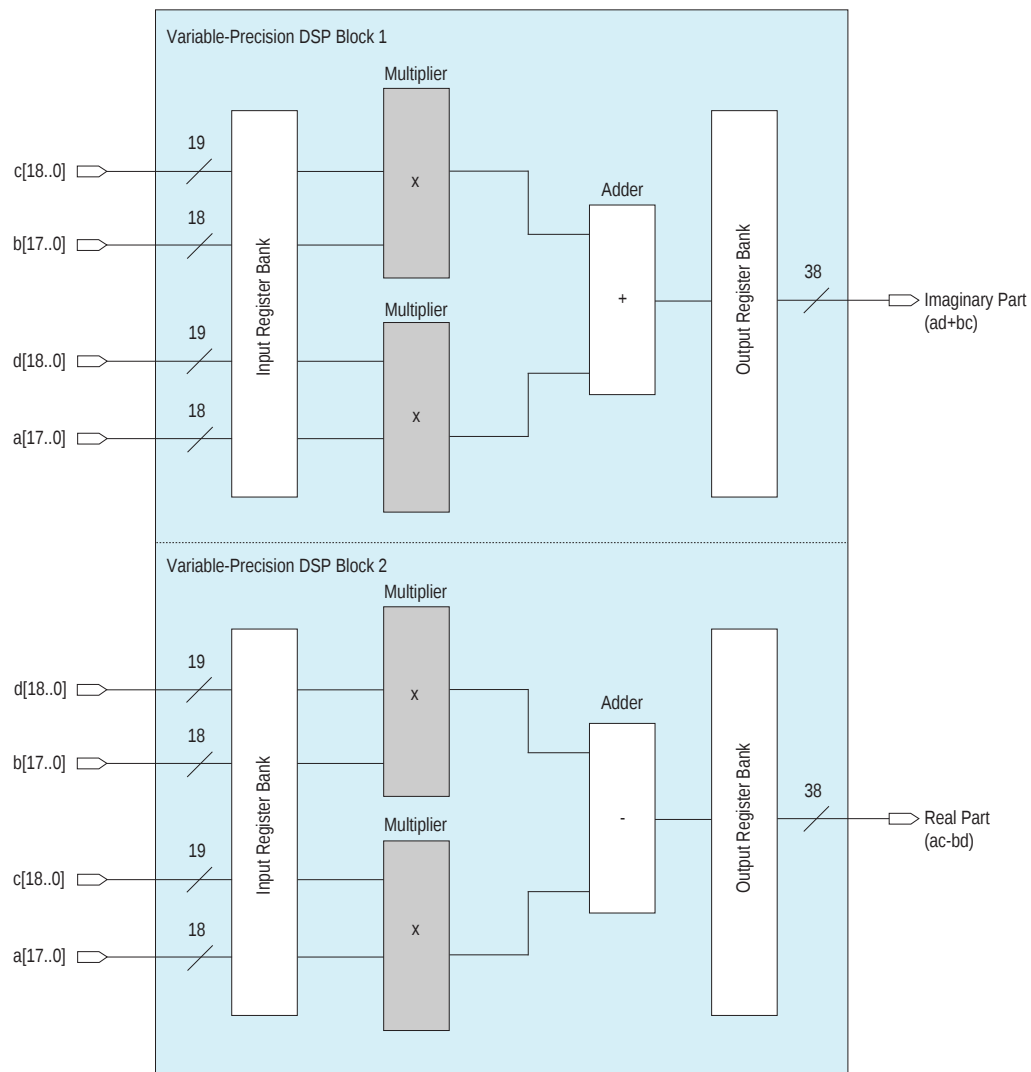
Figure 3-9: Sample of Complex Multiplication Equation

$$(a + jb) \times (c + jd) = [(a \times c) - (b \times d)] + j[(a \times d) + (b \times c)]$$

The imaginary part $[(a \times d) + (b \times c)]$ is implemented in the first variable-precision DSP block, while the real part $[(a \times c) - (b \times d)]$ is implemented in the second variable-precision DSP block.

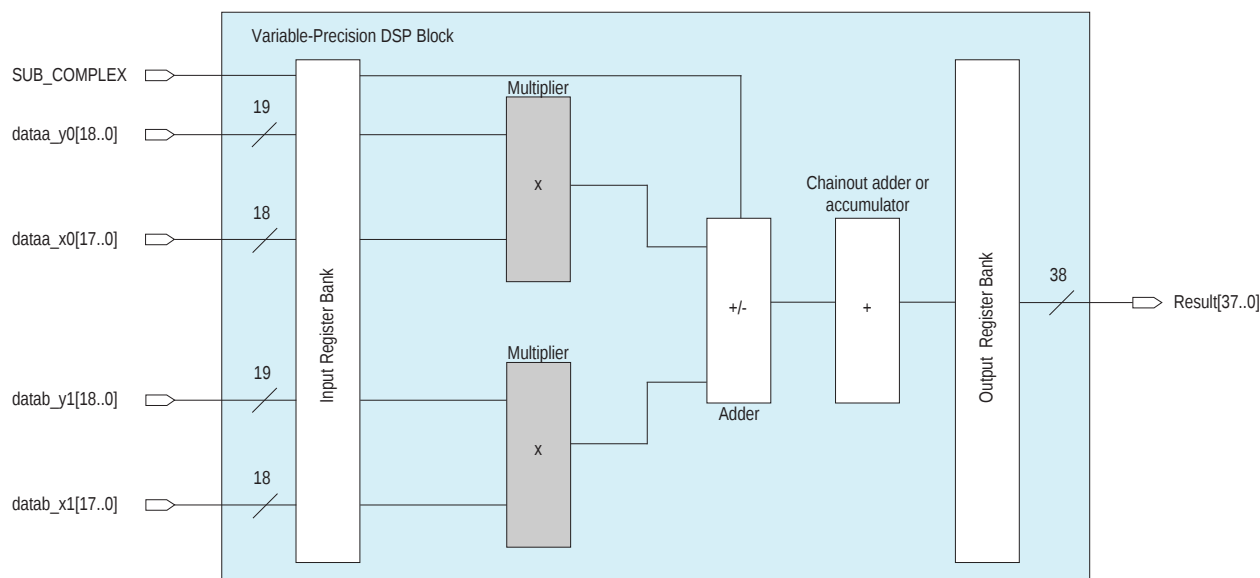
18 x 19 Complex Multiplier

Figure 3-10: One 18 x 19 Complex Multiplier with Two Variable Precision DSP Blocks for Cyclone V Devices



Multiplier Adder Sum Mode

Figure 3-11: One Sum of Two 18 x 19 Multipliers with One Variable Precision DSP Block for Cyclone V Devices

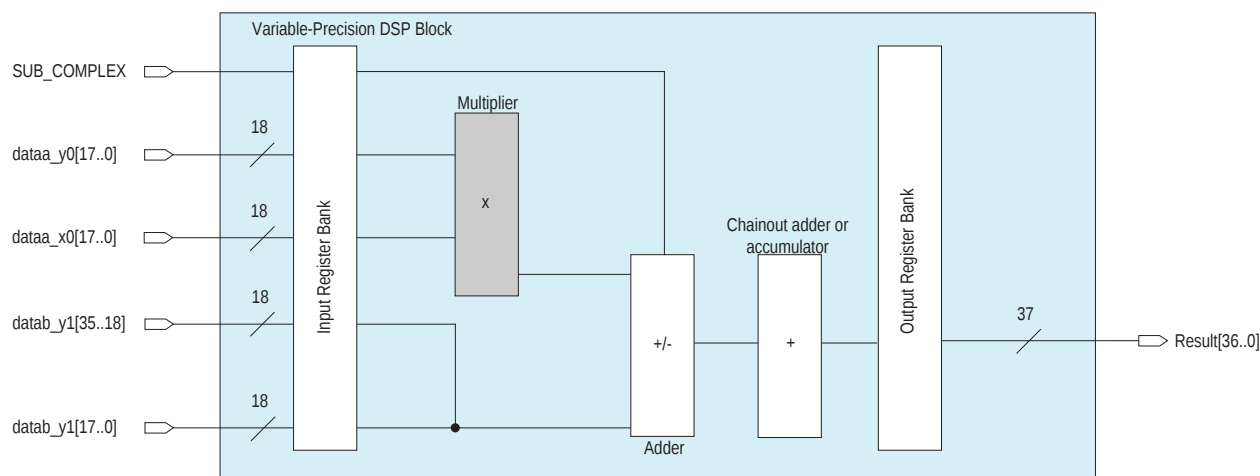


18 x 18 Multiplication Summed with 36-Bit Input Mode

Cyclone V variable precision DSP blocks support one 18 x 18 multiplication summed to a 36-bit input.

Use the upper multiplier to provide the input for an 18 x 18 multiplication, while the bottom multiplier is bypassed. The `datab_y1[17..0]` and `datab_y1[35..18]` signals are concatenated to produce a 36-bit input.

Figure 3-12: One 18 x 18 Multiplication Summed with 36-Bit Input Mode for Cyclone V Devices



Systolic FIR Mode

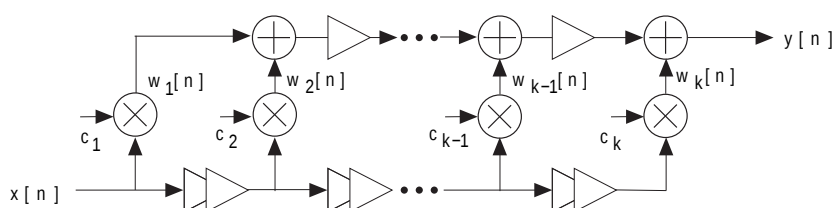
The basic structure of a FIR filter consists of a series of multiplications followed by an addition.

Figure 3-13: Basic FIR Filter Equation

$$y[n] = \sum_{i=1}^k c[i]x[n-i-1]$$

Depending on the number of taps and the input sizes, the delay through chaining a high number of adders can become quite large. To overcome the delay performance issue, the systolic form is used with additional delay elements placed per tap to increase the performance at the cost of increased latency.

Figure 3-14: Systolic FIR Filter Equivalent Circuit



Cyclone V variable precision DSP blocks support the following systolic FIR structures:

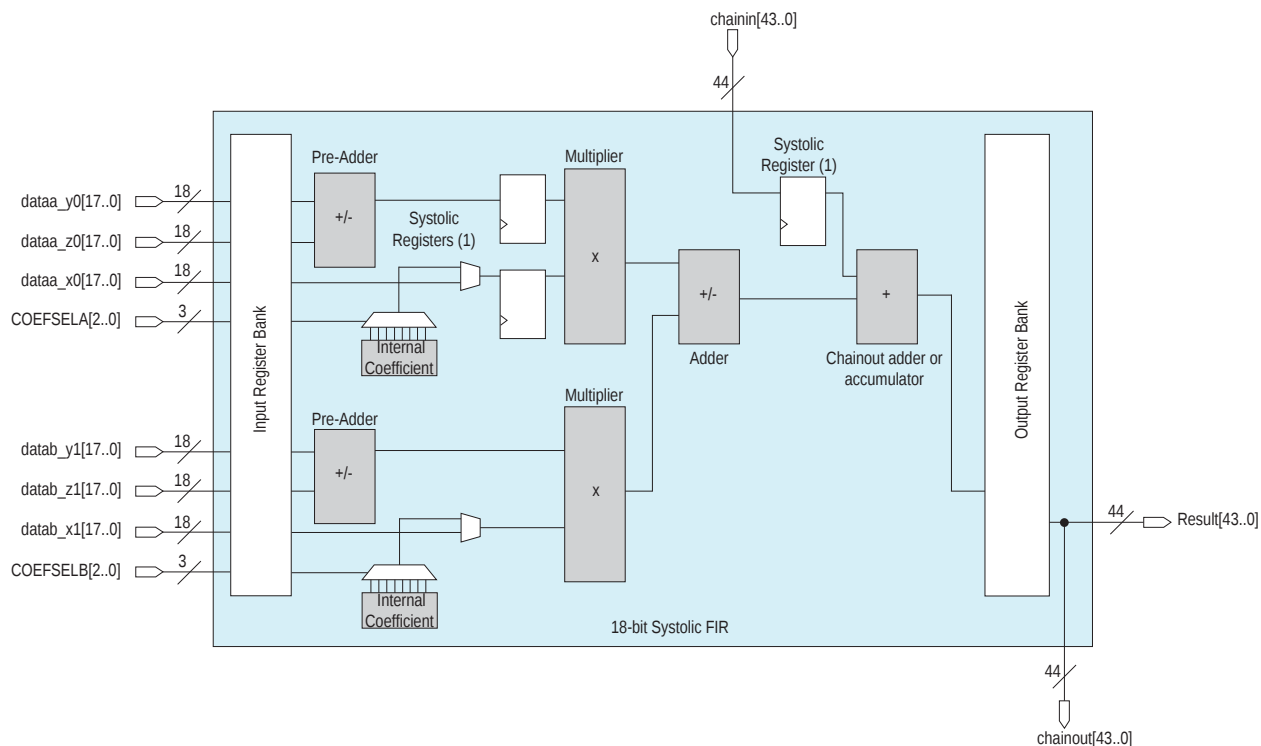
- 18-bit
- 27-bit

In systolic FIR mode, the input of the multiplier can come from four different sets of sources:

- Two dynamic inputs
- One dynamic input and one coefficient input
- One coefficient input and one pre-adder output
- One dynamic input and one pre-adder output

18-Bit Systolic FIR Mode

In 18-bit systolic FIR mode, the adders are configured as dual 44-bit adders, thereby giving 8 bits of overhead when using an 18-bit operation (36-bit products). This allows a total of 256 multiplier products.

Figure 3-15: 18-Bit Systolic FIR Mode for Cyclone V Devices

Note:

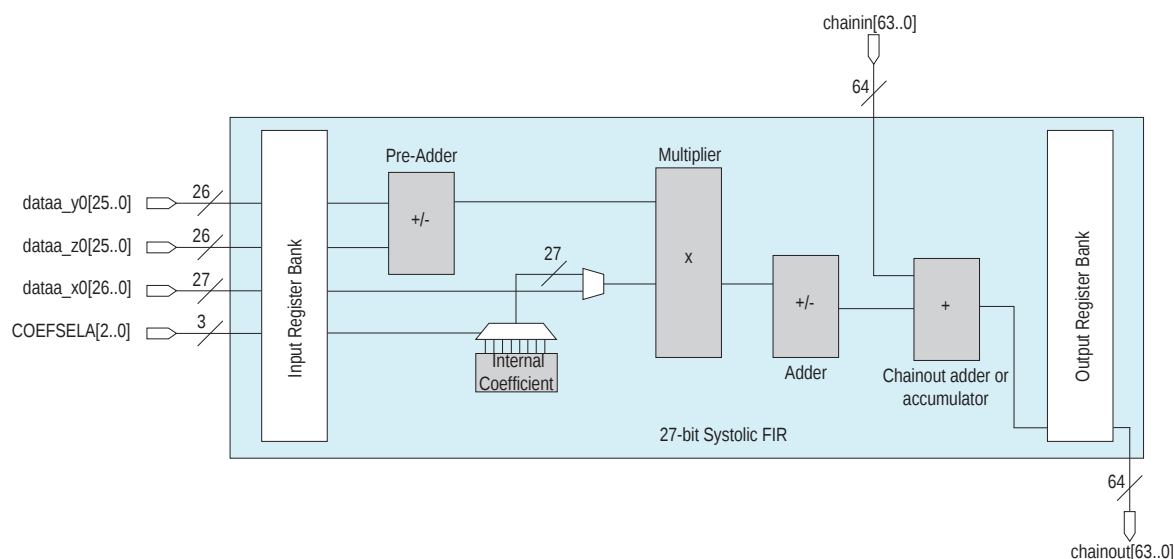
1. The systolic registers have the same clock source as the output register bank.

27-Bit Systolic FIR Mode

In 27-bit systolic FIR mode, the chainout adder or accumulator is configured for a 64-bit operation, providing 10 bits of overhead when using a 27-bit data (54-bit products). This allows a total of 1,024 multiplier products.

The 27-bit systolic FIR mode allows the implementation of one stage systolic filter per DSP block.

Figure 3-16: 27-Bit Systolic FIR Mode for Cyclone V Devices



Document Revision History

Date	Version	Changes
May 2013	2013.05.06	<ul style="list-style-type: none"> Added link to the known document issues in the Knowledge Base. Moved all links to the Related Information section of respective topics for easy reference. Updated the variable DSP blocks and multipliers counts for the Cyclone V SX device variants.
December 2012	2012.12.28	<ul style="list-style-type: none"> Added resources for Cyclone V devices. Updated design considerations for Cyclone V devices in operational modes. Updated Figure 3-10, changed 37 to 38. Updated Figure 3-11, changed 37 to 38 and changed Result[36..0] to Result [37..0].
June 2012	2.0	Updated for the Quartus II software v12.0 release: <ul style="list-style-type: none"> Restructured chapter. Added “Design Considerations”, “Adder”, and “Double Accumulation Register” sections. Updated Figure 3-1 and Figure 3-13. Added Table 3-3. Updated “Systolic Registers” and “Systolic FIR Mode” sections. Added Equation 3-2. Added Figure 3-12.

Date	Version	Changes
May 2011	1.0	Initial release.

2013.05.06

CV-52004



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This chapter describes the advanced features of hierarchical clock networks and phase-locked loops (PLLs) in Cyclone V devices. The Quartus II software enables the PLLs and their features without external devices.

Related Information

[Cyclone V Device Handbook: Known Issues](#)

Lists the planned updates to the *Cyclone V Device Handbook* chapters.

Clock Networks

The Cyclone V devices contain the following clock networks that are organized into a hierarchical structure:

- Global clock (GCLK) networks
- Regional clock (RCLK) networks
- Periphery clock (PCLK) networks

Clock Resources in Cyclone V Devices

The clock networks provide up to 128 unique clock domains. Cyclone V devices support up to 50 unique GCLK, RCLK, and PCLK clock sources (16 GCLKs + 22 RCLKs + 12 PCLKs [for quadrant 1 and quadrant 4 only]) per device quadrant.

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Table 4-1: Clock Resources in Cyclone V Devices—Preliminary

Clock Resource	Device	Number of Resources Available	Source of Clock Resource
Clock input pins	<ul style="list-style-type: none"> Cyclone V E A5, A7, and A9 Cyclone V GX C4, C5, C7, and C9 Cyclone V GT D5, D7, and D9 	24 single-ended or 12 differential	CLK[0..11][p,n] pins
	<ul style="list-style-type: none"> Cyclone V E A2 and A4 Cyclone V GX C3 	18 single-ended or 9 differential	CLK[0..3][p,n], CLK[6][p,n], CLK[8..11][p,n] pins
	<ul style="list-style-type: none"> Cyclone V SE A5 and A6 Cyclone V SX C5 and C6 Cyclone V ST D5 and D6 	16 single-ended or 8 differential	CLK[0..7][p,n] pins
GCLK and RCLK networks	<ul style="list-style-type: none"> Cyclone V E A5, A7, and A9 Cyclone V GX C4, C5, C7, and C9 Cyclone V GT D5, D7, and D9 	<ul style="list-style-type: none"> GCLK networks: 16 RCLK networks: 88 	CLK[0..11][p,n] pins, PLL clock outputs, and logic array
	<ul style="list-style-type: none"> Cyclone V E A2 and A4 Cyclone V GX C3 		CLK[0..3][p,n], CLK[6][p,n], CLK[8..11][p,n] pins, PLL clock outputs, and logic array
	<ul style="list-style-type: none"> Cyclone V SE A5 and A6 Cyclone V SX C5 and C6 Cyclone V ST D5 and D6 	<ul style="list-style-type: none"> GCLK networks: 16 RCLK networks: 66 	CLK[0..7][p,n] pins, PLL clock outputs, and logic array

Clock Resource	Device	Number of Resources Available	Source of Clock Resource
PCLK networks	Cyclone V E A2 and A4		—
	Cyclone V GX C3	6	PLD-transceiver interface clocks, I/O pins, and logic array
	<ul style="list-style-type: none"> Cyclone V E A5 Cyclone V GX C4 and C5 Cyclone V GT D5 	12	
	<ul style="list-style-type: none"> Cyclone V E A7 Cyclone V GX C7 Cyclone V GT D7 Cyclone V SE A5 and A6 Cyclone V SX C5 and C6 Cyclone V ST D5 and D6 	18	
	<ul style="list-style-type: none"> Cyclone V E A9 Cyclone V GX C9 Cyclone V GT D9 	24	
GCLKs and RCLKs per quadrant	All	38	16 GCLKs + 22 RCLKs
GCLKs and RCLKs per device	All	104	16 GCLKs + 88 RCLKs

For more information about the clock input pins connections, refer to the pin connection guidelines.

Related Information

[Cyclone V Device Family Pin Connection Guidelines](#)

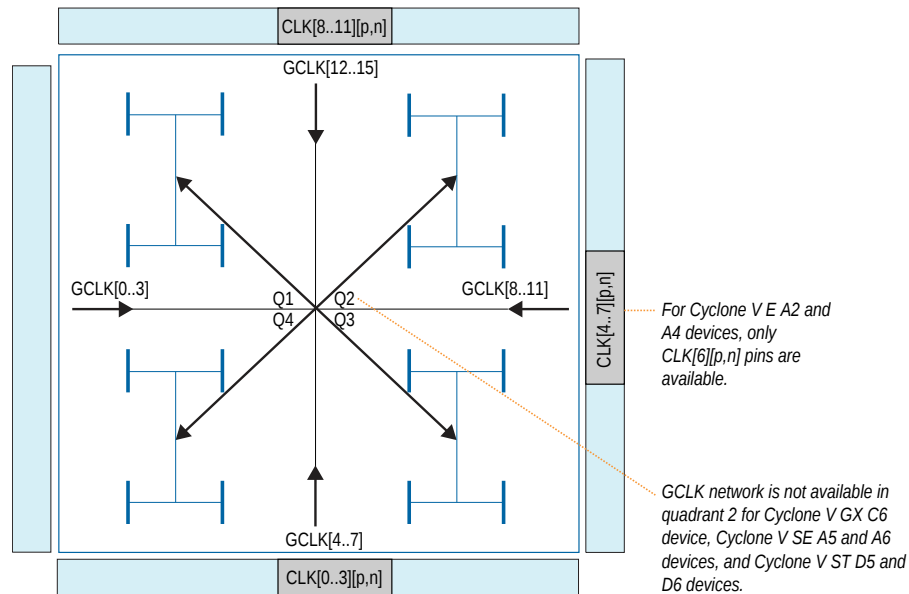
Types of Clock Networks

Global Clock Networks

Cyclone V devices provide GCLKs that can drive throughout the device. The GCLKs serve as low-skew clock sources for functional blocks, such as adaptive logic modules (ALMs), digital signal processing (DSP), embedded memory, and PLLs. Cyclone V I/O elements (IOEs) and internal logic can also drive GCLKs to create internally-generated global clocks and other high fan-out control signals, such as synchronous or asynchronous clear and clock enable signals.

Figure 4-1: GCLK Networks in Cyclone V Devices

This figure represents the top view of the silicon die that corresponds to a reverse view of the device package.

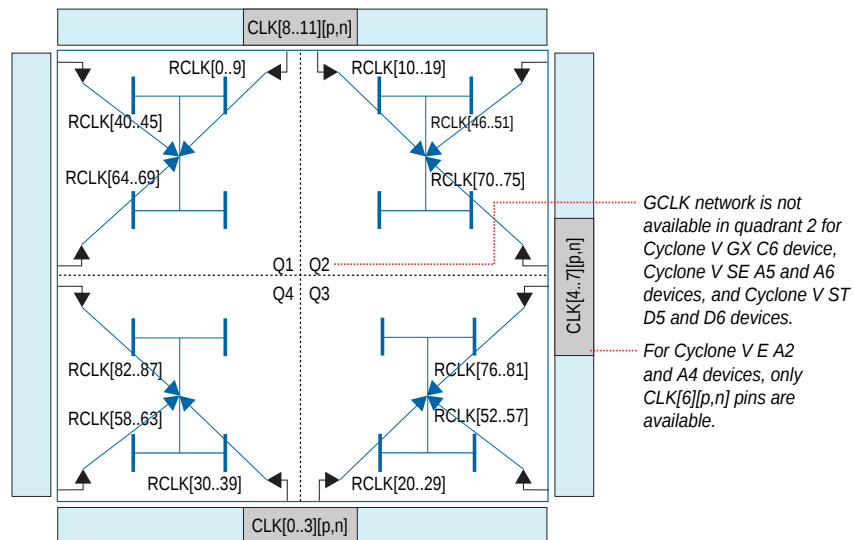


Regional Clock Networks

RCLK networks are only applicable to the quadrant they drive into. RCLK networks provide the lowest clock insertion delay and skew for logic contained within a single device quadrant. The Cyclone V IOEs and internal logic within a given quadrant can also drive RCLKs to create internally generated regional clocks and other high fan-out control signals.

Figure 4-2: RCLK Networks in Cyclone V Devices

This figure represents the top view of the silicon die that corresponds to a reverse view of the device package.



Periphery Clock Networks

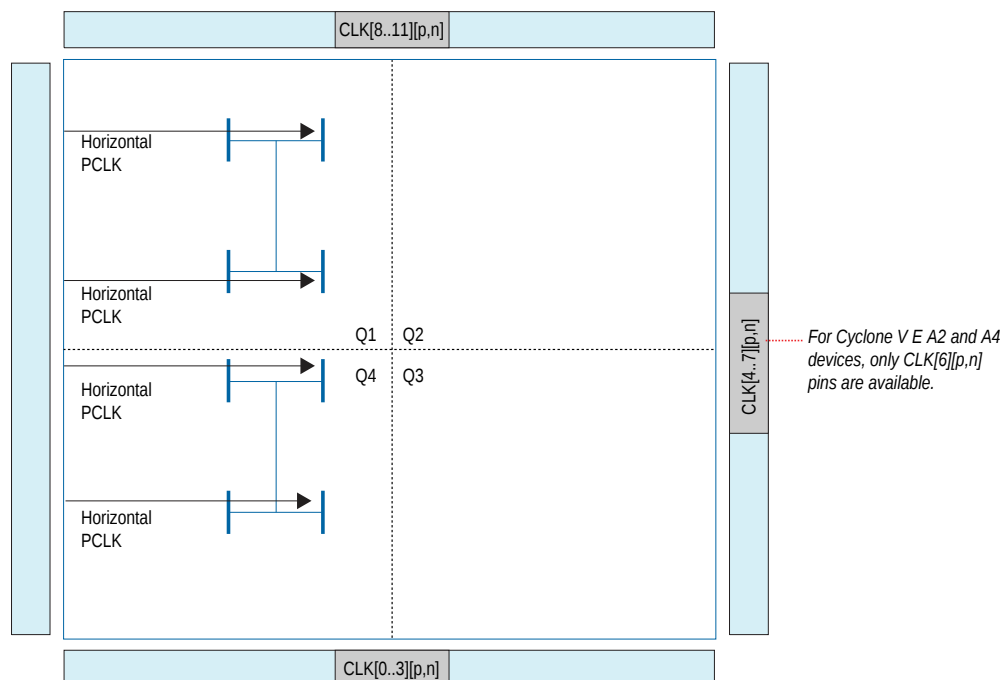
Cyclone V devices provide only horizontal PCLKs from the left periphery.

Clock outputs from the programmable logic device (PLD)-transceiver interface clocks, horizontal I/O pins, and internal logic can drive the PCLK networks.

PCLKs have higher skew when compared with GCLK and RCLK networks. You can use PCLKs for general purpose routing to drive signals into and out of the Cyclone V device.

Figure 4-3: PCLK Networks in Cyclone V Devices

This figure represents the top view of the silicon die that corresponds to a reverse view of the device package.

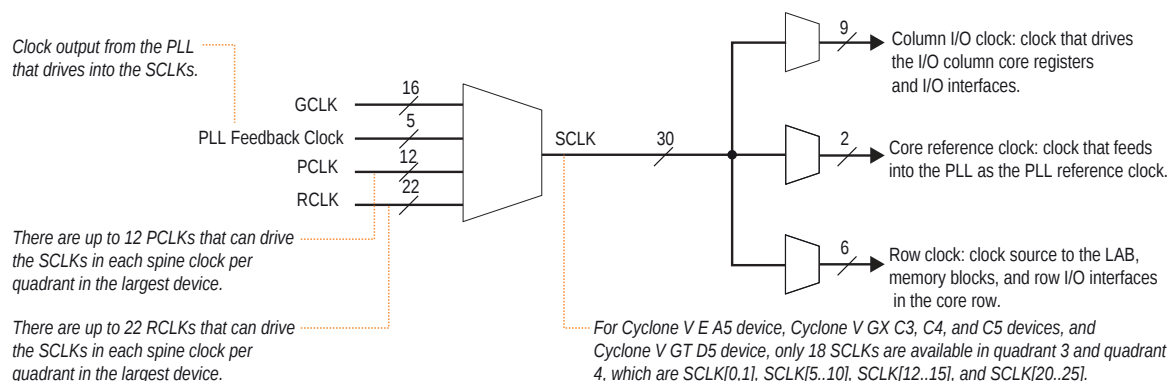


Clock Sources Per Quadrant

The Cyclone V devices provide 30 section clock (SCLK) networks in each spine clock per quadrant. The SCLK networks can drive six row clocks in each logic array block (LAB) row, nine column I/O clocks, and two core reference clocks. The SCLKs are the clock resources to the core functional blocks, PLLs, and I/O interfaces of the device.

A spine clock is another layer of routing between the GCLK, RCLK, and PCLK networks before each clock is connected to the clock routing for each LAB row. The settings for spine clocks are transparent. The Quartus II software automatically routes the spine clock based on the GCLK, RCLK, and PCLK networks.

The following figure shows SCLKs driven by the GCLK, RCLK, PCLK, or the PLL feedback clock networks in each spine clock per quadrant. The GCLK, RCLK, PCLK, and PLL feedback clocks share the same routing to the SCLKs. To ensure successful design fitting in the Quartus II software, the total number of clock resources must not exceed the SCLK limits in each region.

Figure 4-4: Hierarchical Clock Networks in Each Spine Clock Per Quadrant

Types of Clock Regions

This section describes the types of clock regions in Cyclone V devices.

Entire Device Clock Region

To form the entire device clock region, a source drives a signal in a GCLK network that can be routed through the entire device. The source is not necessarily a clock signal. This clock region has the maximum insertion delay when compared with other clock regions, but allows the signal to reach every destination in the device. It is a good option for routing global reset and clear signals or routing clocks throughout the device.

Regional Clock Region

To form a regional clock region, a source drives a signal in a RCLK network that you can route throughout one quadrant of the device. This clock region provides the lowest skew in a quadrant. It is a good option if all the destinations are in a single quadrant.

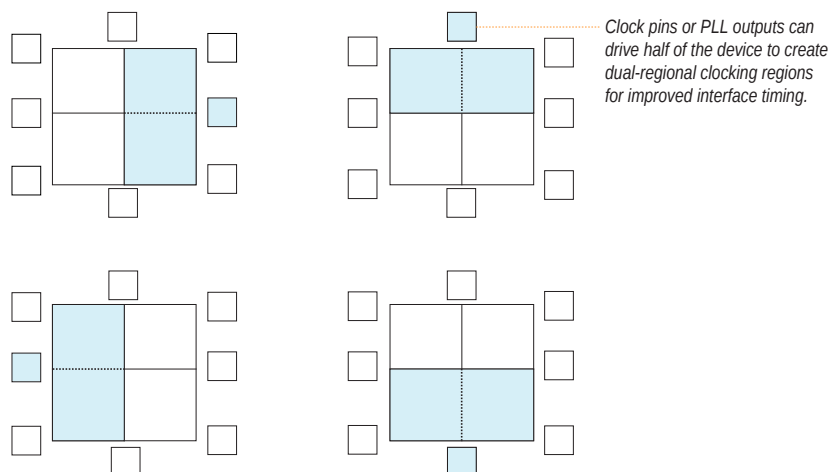
Dual-Regional Clock Region

To form a dual-regional clock region, a single source (a clock pin or PLL output) generates a dual-regional clock by driving two RCLK networks (one from each quadrant). This technique allows destinations across two adjacent device quadrants to use the same low-skew clock. The routing of this signal on an entire side has approximately the same delay as a RCLK region. Internal logic can also drive a dual-regional clock network.

Dual-regional clock region is only supported for quadrant 3 and quadrant 4 in Cyclone V SE, SX, and ST devices.

Figure 4-5: Dual-Regional Clock Region for Cyclone V Devices

This figure represents the top view of the silicon die that corresponds to a reverse view of the device package.



Clock Network Sources

In Cyclone V devices, clock input pins, PLL outputs, high-speed serial interface (HSSI) outputs, and internal logic can drive the GCLK, RCLK, and PCLK networks.

Dedicated Clock Input Pins

You can use the dedicated clock input pins ($\text{CLK}[0..11][p, n]$) for high fan-out control signals, such as asynchronous clears, presets, and clock enables, for protocol signals through the GCLK or RCLK networks.

CLK pins can be either differential clocks or single-ended clocks. When you use the CLK pins as single-ended clock inputs, only the $\text{CLK}<\#>p$ pins have dedicated connections to the PLL. The $\text{CLK}<\#>n$ pins drive the PLLs over global or regional clock networks and do not have dedicated routing paths to the PLLs.

Driving a PLL over a global or regional clock can lead to higher jitter at the PLL input, and the PLL will not be able to fully compensate for the global or regional clock. Altera recommends using the $\text{CLK}<\#>p$ pins for optimal performance when you use single-ended clock inputs to drive the PLLs.

Internal Logic

You can drive each GCLK, RCLK, and horizontal PCLK network using LAB-routing and row clock to enable internal logic to drive a high fan-out, low-skew signal.

Note: Internally-generated GCLKs, RCLKs, or PCLKs cannot drive the Cyclone V PLLs. The input clock to the PLL has to come from dedicated clock input pins, PLL-fed GCLKs, or PLL-fed RCLKs.

HSSI Outputs

Every three HSSI outputs generate a group of four PCLKs to the core.

Related Information

- **PLLs and Clocking** on page 5-12
Provides more information about HSSI outputs.
- **LVDS Interface with External PLL Mode** on page 5-15
Provides more information about HSSI outputs.

PLL Clock Outputs

The Cyclone V PLL clock outputs can drive both GCLK and RCLK networks.

Clock Input Pin Connections to GCLK and RCLK Networks

Table 4-2: Dedicated Clock Input Pin Connectivity to the GCLK Networks for Cyclone V E, GX, and GT Devices—Preliminary

Clock Resources	CLK (p/n Pins)
GCLK[0,1,2,3,4,5,6,7]	CLK[0,1,2,3]
GCLK[8,9,10,11]	CLK[4,5,6,7] ⁽²⁾
GCLK[0,1,2,3,12,13,14,15]	CLK[8,9,10,11]

Table 4-3: Dedicated Clock Input Pin Connectivity to the GCLK Networks for Cyclone V SE, SX, and ST Devices—Preliminary

Clock Resources	CLK (p/n Pins)
GCLK[0,1,2,3,4,5,6,7]	CLK[0,1,2,3]
GCLK[8,9,10,11]	CLK[4,5]
GCLK[0,1,2,3,12,13,14,15]	CLK[6,7]

Table 4-4: Dedicated Clock Input Pin Connectivity to the RCLK Networks for Cyclone V E, GX, and GT Devices—Preliminary

A given clock input pin can drive two adjacent RCLK networks to create a dual-regional clock network.

Clock Resources	CLK (p/n Pins)
RCLK[20,24,28,30,34,38,58,59,60,61,62,63,64,68,82,86]	CLK[0]
RCLK[21,25,29,31,35,39,58,59,60,61,62,63,65,69,83,87]	CLK[1]
RCLK[22,26,32,36,52,53,54,55,56,57,58,59,60,61,62,63,66,84]	CLK[2]
RCLK[23,27,33,37,52,53,54,55,56,57,58,59,60,61,62,63,67,85]	CLK[3]
RCLK[46,47,48,49,50,51,70,74,76,80]	CLK[4] ⁽³⁾
RCLK[46,47,48,49,50,51,71,75,77,81]	CLK[5] ⁽³⁾

⁽²⁾ For Cyclone V E A2 and A4 devices, and Cyclone V GX C3 device, only CLK[6] is available.

⁽³⁾ This applies to all Cyclone V E, GX, and GT devices except for Cyclone V E A2 and A4 devices, and Cyclone V GX C3 device.

Clock Resources	CLK (p/n Pins)
RCLK [52 , 53 , 54 , 55 , 56 , 57 , 72 , 78]	CLK [6]
RCLK [52 , 53 , 54 , 55 , 56 , 57 , 73 , 79]	CLK [7] ⁽³⁾
RCLK [0 , 4 , 8 , 10 , 14 , 18 , 40 , 41 , 42 , 43 , 44 , 45 , 64 , 68 , 82 , 86]	CLK [8]
RCLK [1 , 5 , 9 , 11 , 15 , 19 , 40 , 41 , 42 , 43 , 44 , 45 , 65 , 69 , 83 , 87]	CLK [9]
RCLK [2 , 6 , 12 , 16 , 40 , 41 , 42 , 43 , 44 , 45 , 46 , 47 , 48 , 49 , 50 , 51 , 66 , 84]	CLK [10]
RCLK [3 , 7 , 13 , 17 , 40 , 41 , 42 , 43 , 44 , 45 , 46 , 47 , 48 , 49 , 50 , 51 , 67 , 85]	CLK [11]

Table 4-5: Dedicated Clock Input Pin Connectivity to the RCLK Networks for Cyclone V SE, SX, and ST Devices—Preliminary

A given clock input pin can drive two adjacent RCLK networks to create a dual-regional clock network.

Clock Resources	CLK (p/n pins)
RCLK [20 , 24 , 28 , 30 , 34 , 38 , 58 , 59 , 60 , 61 , 62 , 63 , 64 , 68 , 82 , 86]	CLK [0]
RCLK [21 , 25 , 29 , 31 , 35 , 39 , 58 , 59 , 60 , 61 , 62 , 63 , 65 , 69 , 83 , 87]	CLK [1]
RCLK [22 , 26 , 32 , 36 , 52 , 53 , 54 , 55 , 56 , 57 , 58 , 59 , 60 , 61 , 62 , 63 , 66 , 84]	CLK [2]
RCLK [23 , 27 , 33 , 37 , 52 , 53 , 54 , 55 , 56 , 57 , 58 , 59 , 60 , 61 , 62 , 63 , 67 , 85]	CLK [3]
RCLK [52 , 53 , 54 , 55 , 56 , 57 , 78]	CLK [4]
RCLK [52 , 53 , 54 , 55 , 56 , 57 , 79]	CLK [5]
RCLK [0 , 4 , 8 , 40 , 41 , 42 , 43 , 44 , 45 , 64 , 68 , 82 , 86]	CLK [6]
RCLK [1 , 5 , 9 , 40 , 41 , 42 , 43 , 44 , 45 , 65 , 69 , 83 , 87]	CLK [7]

Clock Output Connections

For Cyclone V PLL connectivity to GCLK and RCLK networks, refer to the PLL connectivity to GCLK and RCLK networks spreadsheet.

Related Information

[PLL Connectivity to GCLK and RCLK Networks for Cyclone V Devices](#)

Clock Control Block

Every GCLK, RCLK, and PCLK network has its own clock control block. The control block provides the following features:

- Clock source selection (dynamic selection available only for GCLKs)
- Global clock multiplexing
- Clock power down (static or dynamic clock enable or disable available only for GCLKs and RCLKs)

Pin Mapping in Cyclone V Devices

Table 4-6: Mapping Between the Input Clock Pins, PLL Counter Outputs, and Clock Control Block Inputs

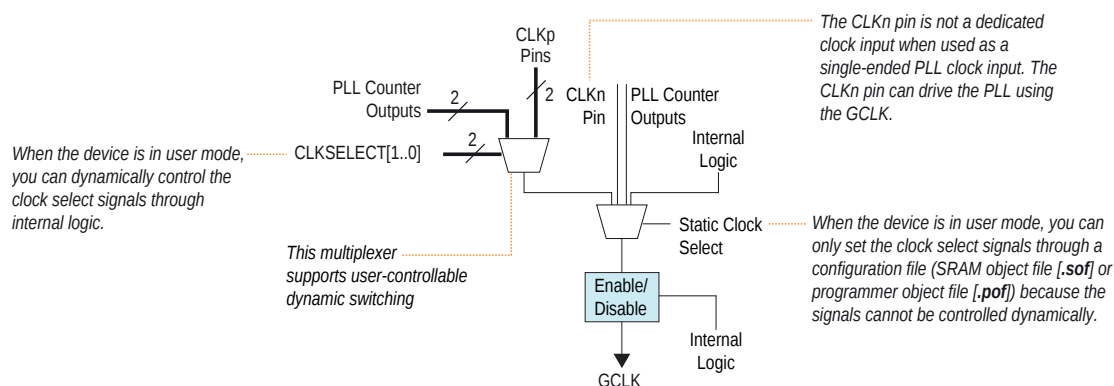
Clock	Fed by
inclk[0] and inclk[1]	Any of the four dedicated clock pins on the same side of the Cyclone V device.
inclk[2]	<ul style="list-style-type: none"> PLL counters C0 and C2 from PLLs on the same side of the clock control block (for top, bottom, and right side of the Cyclone V device). PLL counter C4 from PLLs on the same side of the clock control block (for left side of the Cyclone V device).
inclk[3]	PLL counters C1 and C3 from PLLs on the same side of the clock control block (for top, bottom, and right side of the Cyclone V device). This input clock port is not connected for the clock control block on left side of the Cyclone V device.

GCLK Control Block

You can select the clock source for the GCLK select block either statically or dynamically using internal logic to drive the multiplexer-select inputs.

When selecting the clock source dynamically, you can select up to two PLL counter outputs and up to two clock pins.

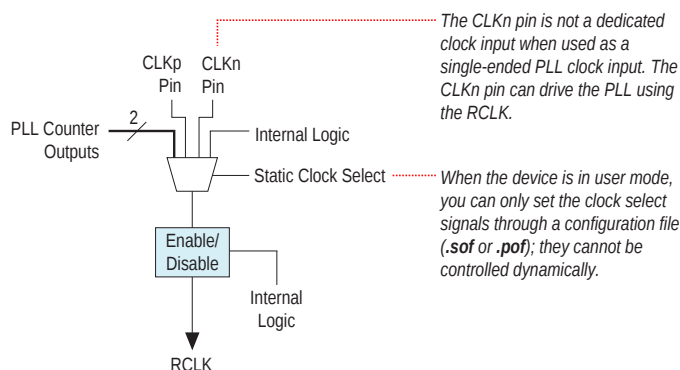
Figure 4-6: GCLK Control Block for Cyclone V Devices



RCLK Control Block

You can only control the clock source selection for the RCLK select block statically using configuration bit settings in the configuration file (.sof or .pof) generated by the Quartus II software.

Figure 4-7: RCLK Control Block for Cyclone V Devices



You can set the input clock sources and the `clkena` signals for the GCLK and RCLK network multiplexers through the Quartus II software using the ALTCLKCTRL megafunction.

Note: When selecting the clock source dynamically using the ALTCLKCTRL megafunction, choose the inputs using the `CLKSELECT[0..1]` signal. The inputs from the clock pins feed the `inclk[0..1]` ports of the multiplexer, and the PLL outputs feed the `inclk[2..3]` ports.

Related Information

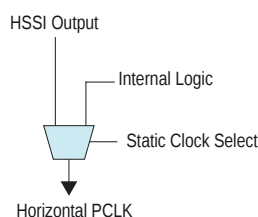
[Clock Control Block \(ALTCLKCTRL\) Megafunction User Guide](#)

Provides more information about ALTCLKCTRL megafunction.

PCLK Control Block

To drive the HSSI horizontal PCLK control block, select the HSSI output or internal logic.

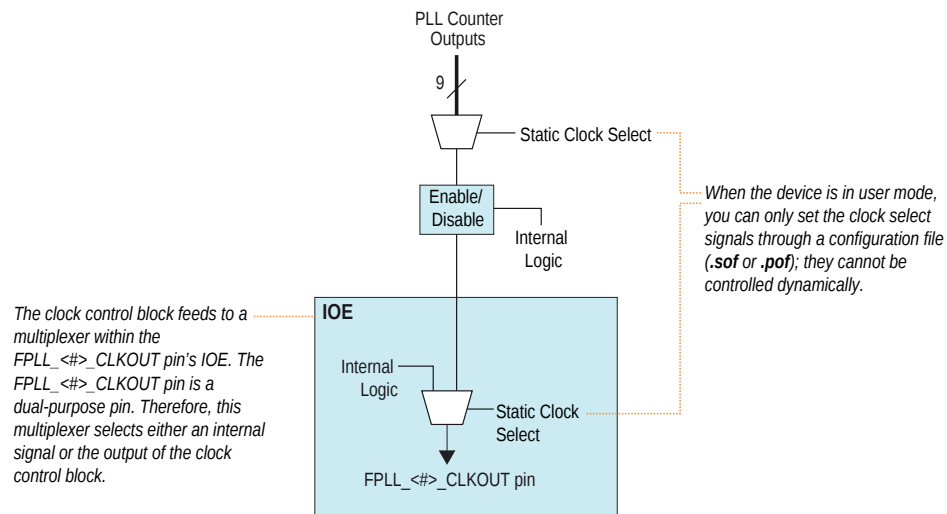
Figure 4-8: Horizontal PCLK Control Block for Cyclone V Devices



External PLL Clock Output Control Block

You can enable or disable the dedicated external clock output pins using the ALTCLKCTRL megafunction.

Figure 4-9: External PLL Output Clock Control Block for Cyclone V Devices

**Related Information****Clock Control Block (ALTCLKCTRL) Megafunction User Guide**

Provides more information about ALTCLKCTRL megafunction.

Clock Power Down

You can power down the GCLK and RCLK clock networks using both static and dynamic approaches.

When a clock network is powered down, all the logic fed by the clock network is in off-state, reducing the overall power consumption of the device. The unused GCLK, RCLK, and PCLK networks are automatically powered down through configuration bit settings in the configuration file (.sof or .pof) generated by the Quartus II software.

The dynamic clock enable or disable feature allows the internal logic to control power-up or power-down synchronously on the GCLK and RCLK networks, including dual-regional clock regions. This feature is independent of the PLL and is applied directly on the clock network.

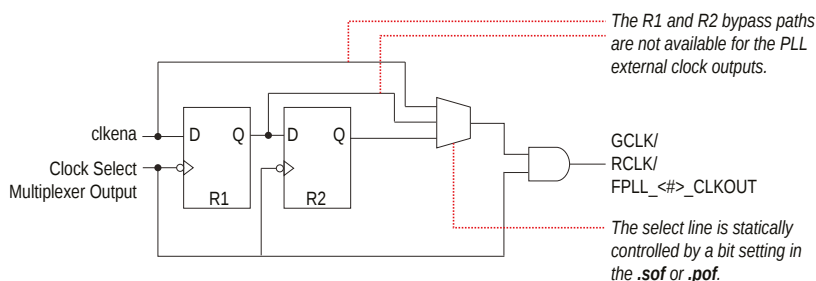
Note: You cannot dynamically enable or disable GCLK or RCLK networks that drive PLLs.

Clock Enable Signals

You cannot use the clock enable and disable circuit of the clock control block if the GCLK or RCLK output drives the input of a PLL.

Figure 4-10: `clkena` Implementation with Clock Enable and Disable Circuit

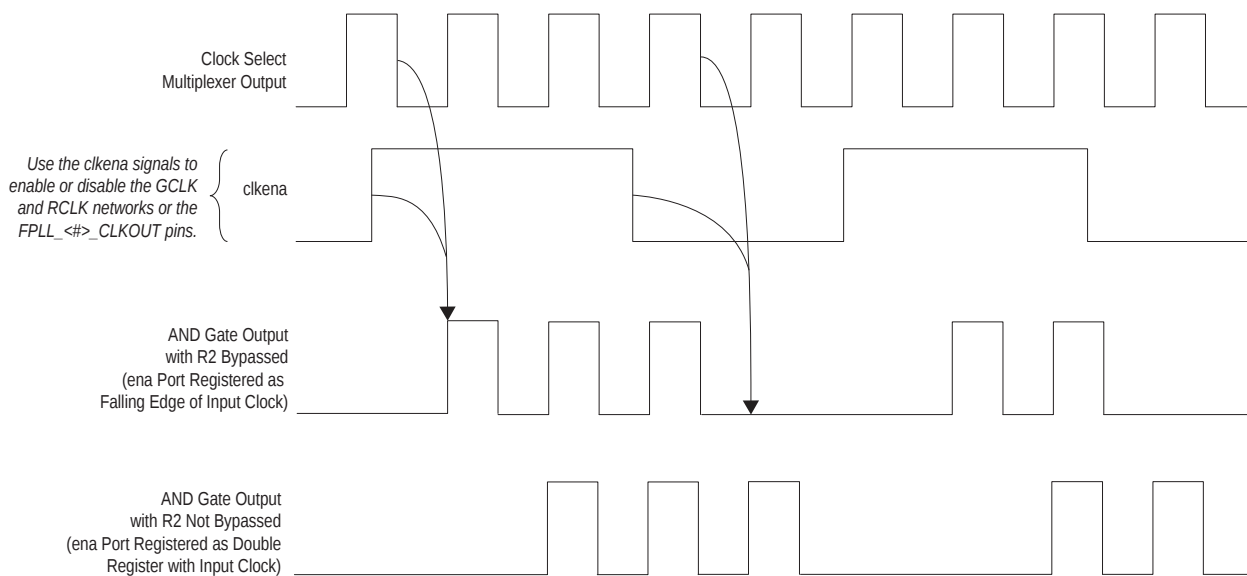
This figure shows the implementation of the clock enable and disable circuit of the clock control block.



The `clkena` signals are supported at the clock network level instead of at the PLL output counter level. This allows you to gate off the clock even when you are not using a PLL. You can also use the `clkena` signals to control the dedicated external clocks from the PLLs.

Figure 4-11: Example of `clkena` Signals

This figure shows a waveform example for a clock output enable. The `clkena` signal is synchronous to the falling edge of the clock output.



Cyclone V devices have an additional metastability register that aids in asynchronous enable and disable of the GCLK and RCLK networks. You can optionally bypass this register in the Quartus II software.

The PLL can remain locked, independent of the `clkena` signals, because the loop-related counters are not affected. This feature is useful for applications that require a low-power or sleep mode. The `clkena` signal can also disable clock outputs if the system is not tolerant of frequency overshoot during resynchronization.

Cyclone V PLLs

PLLs provide robust clock management and synthesis for device clock management, external system clock management, and high-speed I/O interfaces.

The Cyclone V device family contains fractional PLLs that can function as fractional PLLs or integer PLLs. The output counters in Cyclone V devices are dedicated to each fractional PLL that support integer or fractional frequency synthesis.

The Cyclone V devices offer up to 8 fractional PLLs in the larger densities.

Table 4-7: PLL Features in Cyclone V Devices —Preliminary

Feature	Support
Integer PLL	Yes
Fractional PLL	Yes
C output counters	9
M, N, C counter sizes	1 to 512
Dedicated external clock outputs	2 single-ended and 1 differential
Dedicated clock input pins	4 single-ended or 4 differential
External feedback input pin	Single-ended or differential
Spread-spectrum input clock tracking	Yes ⁽⁴⁾
Source synchronous compensation	Yes
Direct compensation	Yes
Normal compensation	Yes
Zero-delay buffer compensation	Yes
External feedback compensation	Yes
LVDS compensation	Yes
Phase shift resolution	78.125 ps ⁽⁵⁾
Programmable duty cycle	Yes
Power down mode	Yes

⁽⁴⁾ Provided input clock jitter is within input jitter tolerance specifications. The modulation frequency of the input clock is below the PLL bandwidth which is specified in the Fitter report.

⁽⁵⁾ The smallest phase shift is determined by the voltage-controlled oscillator (VCO) period divided by eight. For degree increments, the Cyclone V device can shift all output frequencies in increments of at least 45°. Smaller degree increments are possible depending on the frequency and divide parameters.

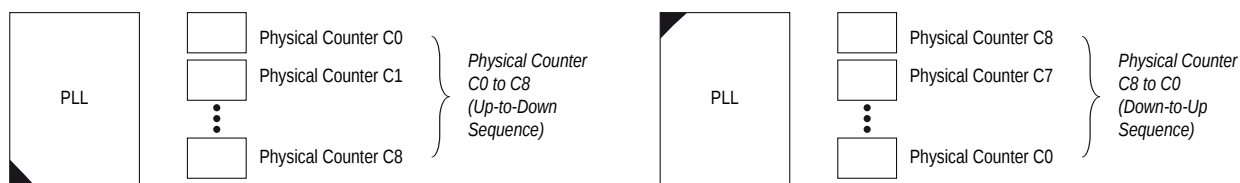
PLL Physical Counters in Cyclone V Devices

The physical counters for the fractional PLLs are arranged in the following sequences:

- Up-to-down
- Down-to-up

Figure 4-12: PLL Physical Counters Orientation for Cyclone V Devices

This figure represents the top view of the silicon die that corresponds to a reverse view of the device package.



PLL Locations in Cyclone V Devices

Cyclone V devices provide a PLL for each group of three transceiver channels. These PLLs are located in a strip, where the strip refers to an area in the FPGA.

For the PLL in the strip, only PLL counter C[4..8] of the strip fractional PLLs are used in a clock network. PLL counter C[0..3] are used for supporting high-speed requirement of HSSI applications.

The total number of PLLs in the Cyclone V devices includes the PLLs in the PLL strip. However, the transceivers can only use the PLLs located in the strip.

The following figures show the physical locations of the fractional PLLs. Every index represents one fractional PLL in the device. The physical locations of the fractional PLLs correspond to the coordinates in the Quartus II Chip Planner.

Figure 4-13: PLL Locations for Cyclone V E A2 and A4 Devices

This figure represents the top view of the silicon die that corresponds to a reverse view of the device package.

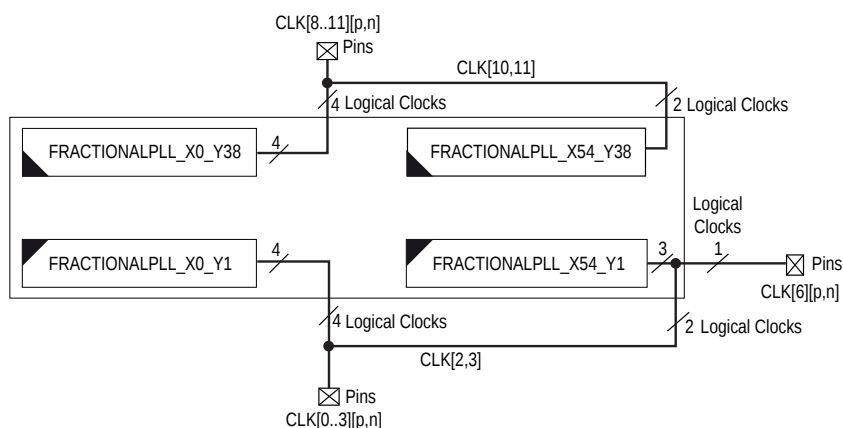
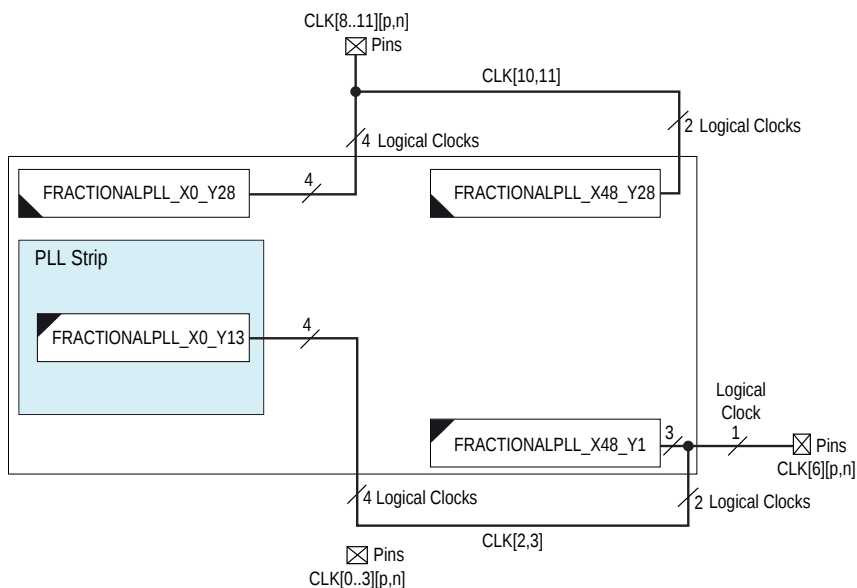


Figure 4-14: PLL Locations for Cyclone V GX C3 Device

This figure represents the top view of the silicon die that corresponds to a reverse view of the device package.

**Figure 4-15: PLL Locations for Cyclone V E A5 Device, Cyclone V GX C4 and C5 Devices, and Cyclone V GT D5 Device**

This figure represents the top view of the silicon die that corresponds to a reverse view of the device package.

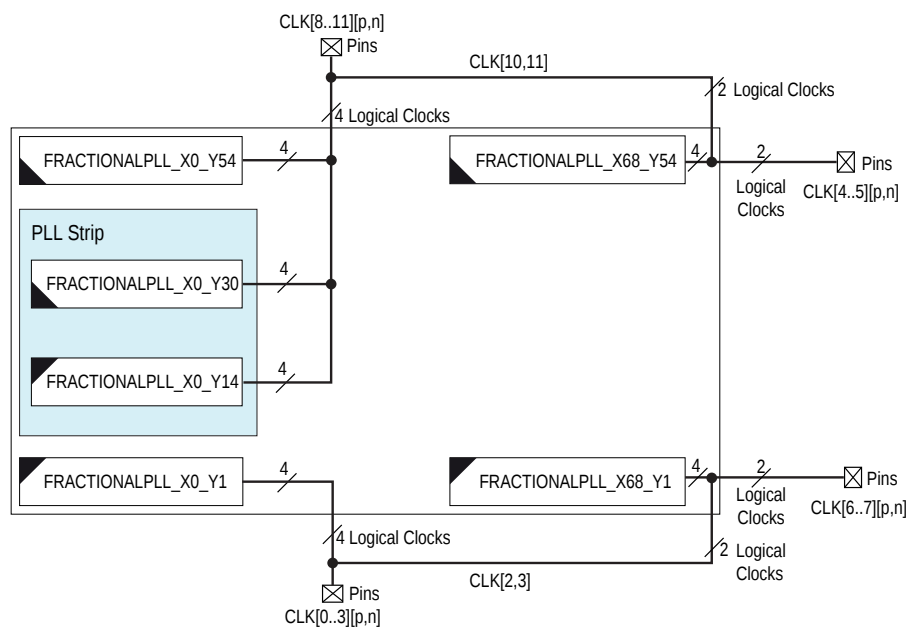


Figure 4-16: PLL Locations for Cyclone V E A7 Device, Cyclone V GX C7 Device, Cyclone V GT D7 Device, Cyclone V SE A5 and A6 Devices, Cyclone V SX C5 and C6 Devices, and Cyclone V ST D5 and D6 Devices

This figure represents the top view of the silicon die that corresponds to a reverse view of the device package.

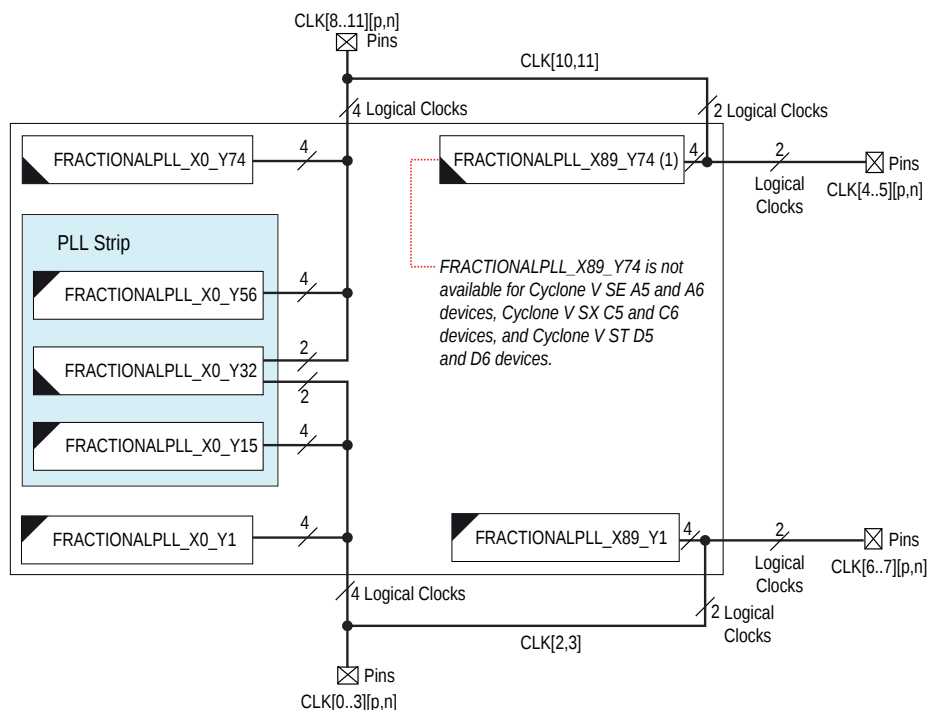
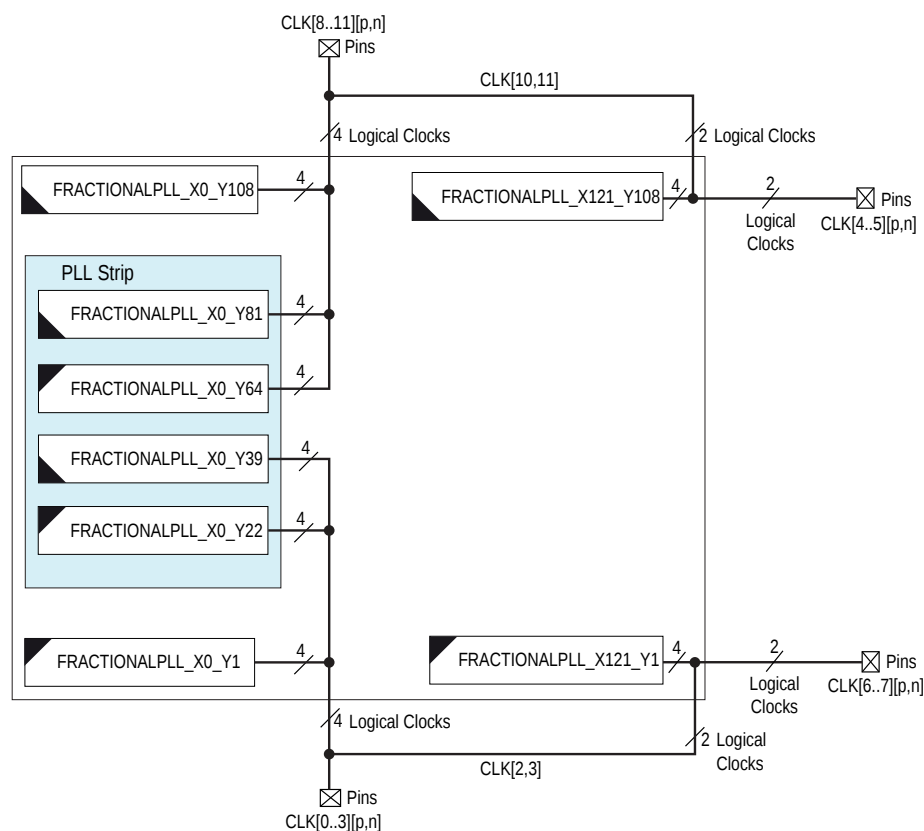


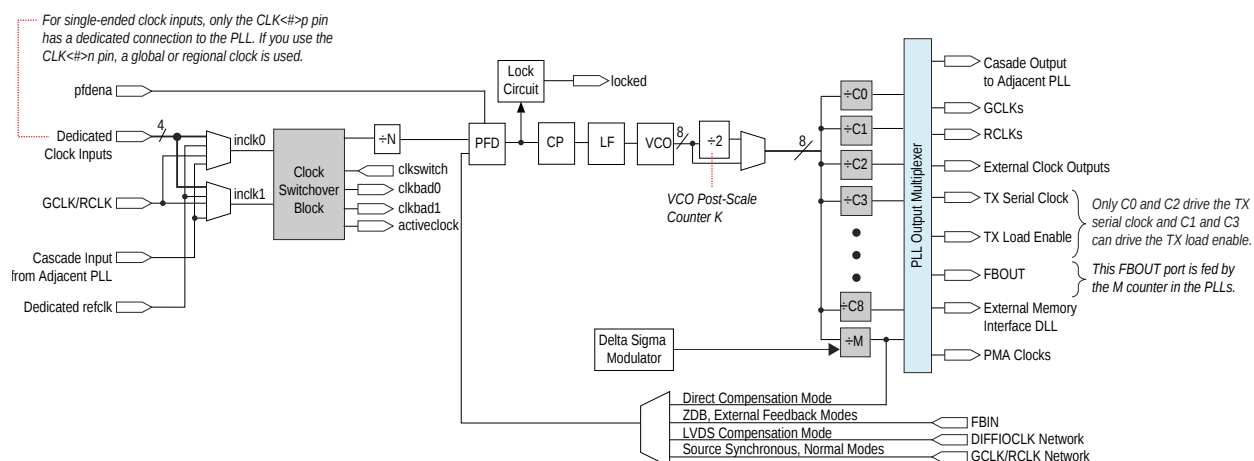
Figure 4-17: PLL Locations for Cyclone V E A9 Device, Cyclone V GX C9 Device, and Cyclone V GT D9 Device

This figure represents the top view of the silicon die that corresponds to a reverse view of the device package.



Fractional PLL Architecture

Figure 4-18: Fractional PLL High-Level Block Diagram for Cyclone V Devices



Fractional PLL Usage

You can configure the fractional PLL to function either in the integer or in the enhanced fractional mode. One fractional PLL can use up to 9 output counters and all external clock outputs.

Fractional PLLs can be used as follows:

- Reduce the number of required oscillators on the board
- Reduce the clock pins used in the FPGA by synthesizing multiple clock frequencies from a single reference clock source
- Compensate clock network delay
- Zero delay buffering
- Transmit clocking for transceivers

PLL External Clock I/O Pins

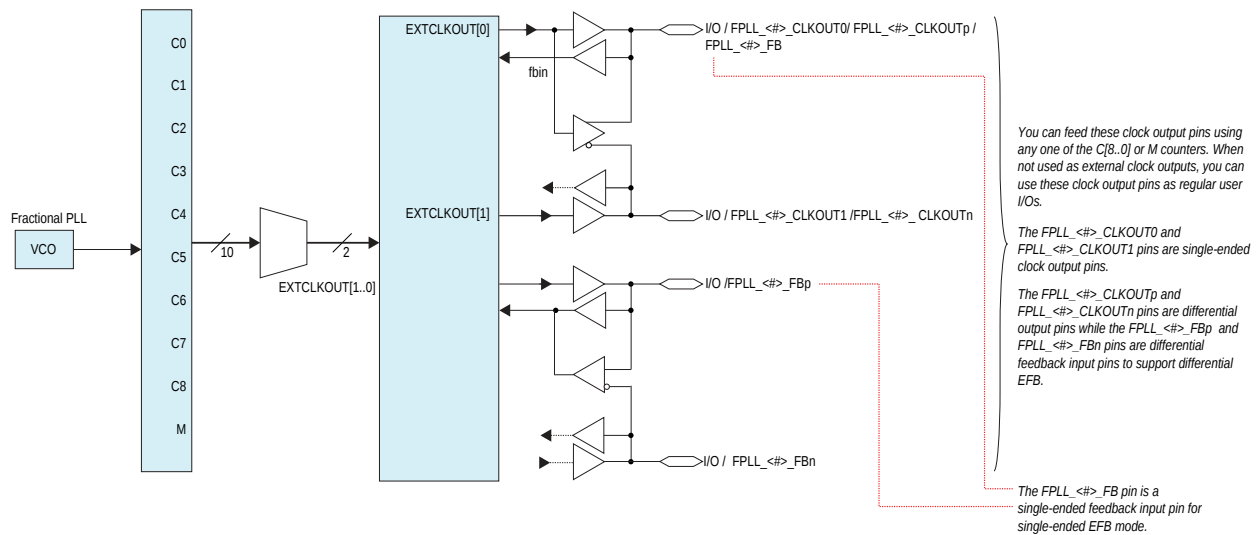
All Cyclone V external clock outputs for corner fractional PLLs (that are not from the PLL strips) are dual-purpose clock I/O pins. Two external clock output pins associated with each corner fractional PLL are organized as one of the following combinations:

- Two single-ended clock outputs
- One differential clock output
- Two single-ended clock outputs and one single-ended clock input in the I/O driver feedback for zero delay buffer (ZDB) mode support
- One single-ended clock output and one single-ended feedback input for single-ended external feedback (EFB) mode support
- One differential clock output and one differential feedback input for differential EFB support

Note: The middle fractional PLLs on the left side of Cyclone V E A7 device, Cyclone V GX C7 device, and Cyclone V GT D7 device do not support external clock outputs.

The following figure shows that any of the output counters ($C[0..8]$) or the M counter on the PLLs can feed the dedicated external clock outputs. Therefore, one counter or frequency can drive all output pins available from a given PLL.

Figure 4-19: Dual-Purpose Clock I/O Pins Associated with PLL for Cyclone V Devices



Each pin of a single-ended output pair can be either in-phase or 180° out-of-phase. To implement the 180° out-of-phase pin in a pin pair, the Quartus II software places a NOT gate in the design into the IOE.

The clock output pin pairs support the following I/O standards:

- Same I/O standard for the pin pairs
- LVDS
- Differential high-speed transceiver logic (HSTL)
- Differential SSTL

Cyclone V PLLs can drive out to any regular I/O pin through the GCLK or RCLK network. You can also use the external clock output pins as user I/O pins if you do not require external PLL clocking.

Related Information

- [I/O Features in Cyclone V Devices](#)
Provides more information about I/O standards supported by the PLL clock input and output pins.
- [Zero-Delay Buffer Mode](#) on page 4-24
- [External Feedback Mode](#) on page 4-25

PLL Control Signals

You can use the `areset` signal to control PLL operation and resynchronization, and use the `locked` signal to observe the status of the PLL.

areset

The `areset` signal is the reset or resynchronization input for each PLL. The device input pins or internal logic can drive these input signals.

When `areset` is driven high, the PLL counters reset, clearing the PLL output and placing the PLL out-of-lock. The VCO is then set back to its nominal setting. When `areset` is driven low again, the PLL resynchronizes to its input as it re-locks.

You must assert the `areset` signal every time the PLL loses lock to guarantee the correct phase relationship between the PLL input and output clocks. You can set up the PLL to automatically reset (self-reset) after a loss-of-lock condition using the Quartus II MegaWizard Plug-In Manager.

You must include the `areset` signal if either of the following conditions is true:

- PLL reconfiguration or clock switchover is enabled in the design
- Phase relationships between the PLL input and output clocks must be maintained after a loss-of-lock condition

Note: If the input clock to the PLL is not toggling or is unstable after power up, assert the `areset` signal after the input clock is stable and within specifications.

locked

The `locked` signal output of the PLL indicates the following conditions:

- The PLL has locked onto the reference clock.
- The PLL clock outputs are operating at the desired phase and frequency set in the MegaWizard Plug-In Manager.

The lock detection circuit provides a signal to the core logic. The signal indicates when the feedback clock has locked onto the reference clock both in phase and frequency.

Clock Feedback Modes

This section describes the following clock feedback modes:

- Source synchronous
- LVDS compensation
- Direct compensation
- Normal
- ZDB
- EFB

Each mode allows clock multiplication and division, phase shifting, and programmable duty cycle.

The input and output delays are fully compensated by a PLL only when using the dedicated clock input pins associated with a given PLL as the clock source.

The input and output delays may not be fully compensated in the Quartus II software for the following conditions:

- When a GCLK or RCLK network drives the PLL
- When the PLL is driven by a dedicated clock pin that is not associated with the PLL

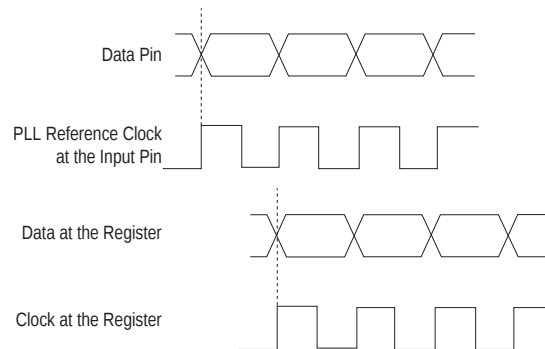
For example, when you configure a PLL in ZDB mode, the PLL input is driven by an associated dedicated clock input pin. In this configuration, a fully compensated clock path results in zero delay between the clock input and one of the clock outputs from the PLL. However, if the PLL input is fed by a non-dedicated input (using the GCLK network), the output clock may not be perfectly aligned with the input clock.

Source Synchronous Mode

If the data and clock arrive at the same time on the input pins, the same phase relationship is maintained at the clock and data ports of any IOE input register. Data and clock signals at the IOE experience similar buffer delays as long as you use the same I/O standard.

Altera recommends source synchronous mode for source synchronous data transfers.

Figure 4-20: Example of Phase Relationship Between Clock and Data in Source Synchronous Mode



The source synchronous mode compensates for the delay of the clock network used and any difference in the delay between the following two paths:

- Data pin to the IOE register input
- Clock input pin to the PLL phase frequency detector (PFD) input

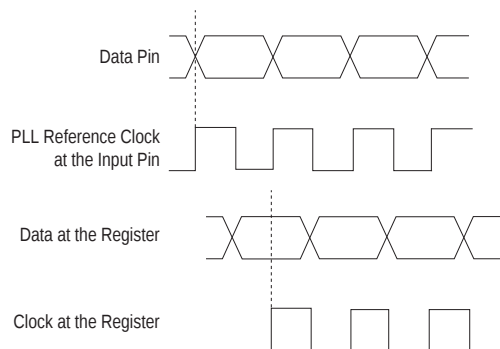
The Cyclone V PLL can compensate multiple pad-to-input-register paths, such as a data bus when it is set to use source synchronous compensation mode.

Source Synchronous Mode for LVDS Compensation

The purpose of source synchronous mode is to maintain the same data and clock timing relationship seen at the pins of the internal serializer/deserializer (SERDES) capture register, except that the clock is inverted (180° phase shift). Thus, source synchronous mode ideally compensates for the delay of the LVDS clock network, including the difference in delay between the following two paths:

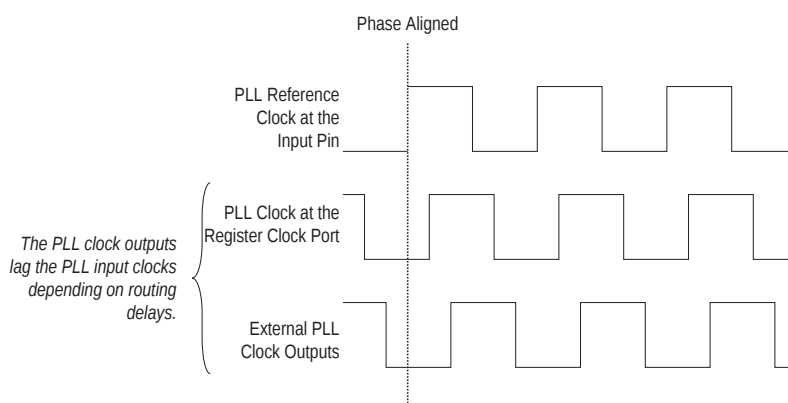
- Data pin-to-SERDES capture register
- Clock input pin-to-SERDES capture register

The output counter must provide the 180° phase shift.

Figure 4-21: Example of Phase Relationship Between the Clock and Data in LVDS Compensation Mode

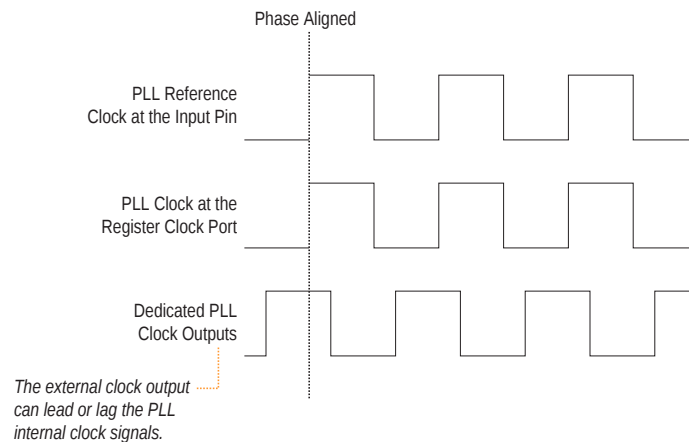
Direct Compensation Mode

In direct compensation mode, the PLL does not compensate for any clock networks. This mode provides better jitter performance because the clock feedback into the PFD passes through less circuitry. Both the PLL internal- and external-clock outputs are phase-shifted with respect to the PLL clock input.

Figure 4-22: Example of Phase Relationship Between the PLL Clocks in Direct Compensation Mode

Normal Mode

An internal clock in normal mode is phase-aligned to the input clock pin. The external clock output pin has a phase delay relative to the clock input pin if connected in this mode. The Quartus II TimeQuest Timing Analyzer reports any phase difference between the two. In normal mode, the delay introduced by the GCLK or RCLK network is fully compensated.

Figure 4-23: Example of Phase Relationship Between the PLL Clocks in Normal Mode

Zero-Delay Buffer Mode

In ZDB mode, the external clock output pin is phase-aligned with the clock input pin for zero delay through the device. This mode is supported on all Cyclone V PLLs.

When using this mode, you must use the same I/O standard on the input clocks and clock outputs to guarantee clock alignment at the input and output pins. You cannot use differential I/O standards on the PLL clock input or output pins.

To ensure phase alignment between the `clk` pin and the external clock output (`CLKOUT`) pin in ZDB mode, instantiate a bidirectional I/O pin in the design. The bidirectional I/O pin serves as the feedback path connecting the `fbout` and `fbin` ports of the PLL. The bidirectional I/O pin must always be assigned a single-ended I/O standard. The PLL uses this bidirectional I/O pin to mimic and compensate for the output delay from the clock output port of the PLL to the external clock output pin.

Note: To avoid signal reflection when using ZDB mode, do not place board traces on the bidirectional I/O pin.

Figure 4-24: ZDB Mode in Cyclone V PLLs

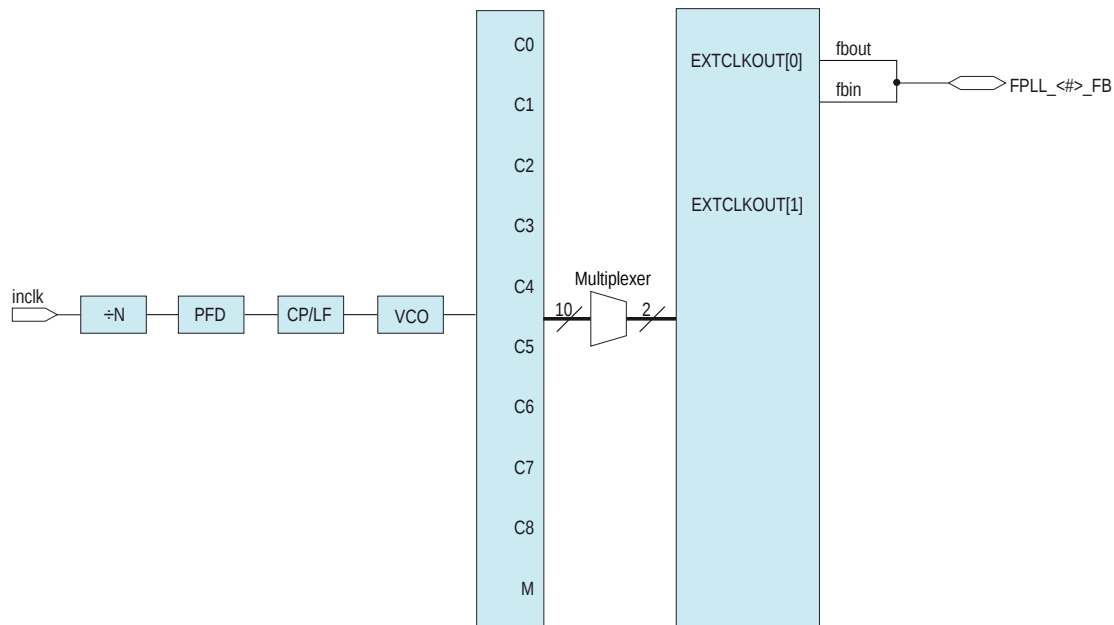
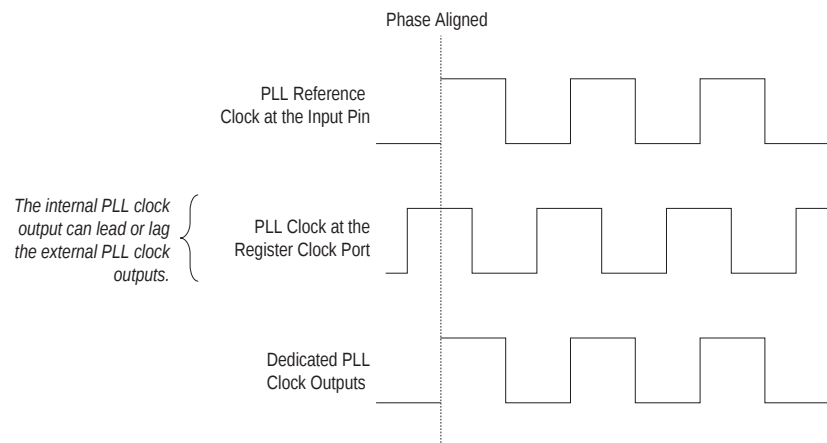


Figure 4-25: Example of Phase Relationship Between the PLL Clocks in ZDB Mode

**Related Information**

[PLL External Clock I/O Pins](#) on page 4-19

Provides more information about PLL clock outputs.

External Feedback Mode

In EFB mode, the output of the M counter (*fbout*) feeds back to the PLL *fbin* input (using a trace on the board) and becomes part of the feedback loop.

One of the dual-purpose external clock outputs becomes the `fbin` input pin in this mode. The external feedback input pin, `fbin` is phase-aligned with the clock input pin. Aligning these clocks allows you to remove clock delay and skew between devices.

When using EFB mode, you must use the same I/O standard on the input clock, feedback input, and clock outputs.

This mode is supported only on the corner fractional PLLs. For Cyclone V E A2 and A4 devices, and Cyclone V GX C3 device, EFB mode is supported only on the left corner fractional PLLs.

Figure 4-26: EFB Mode in Cyclone V Devices

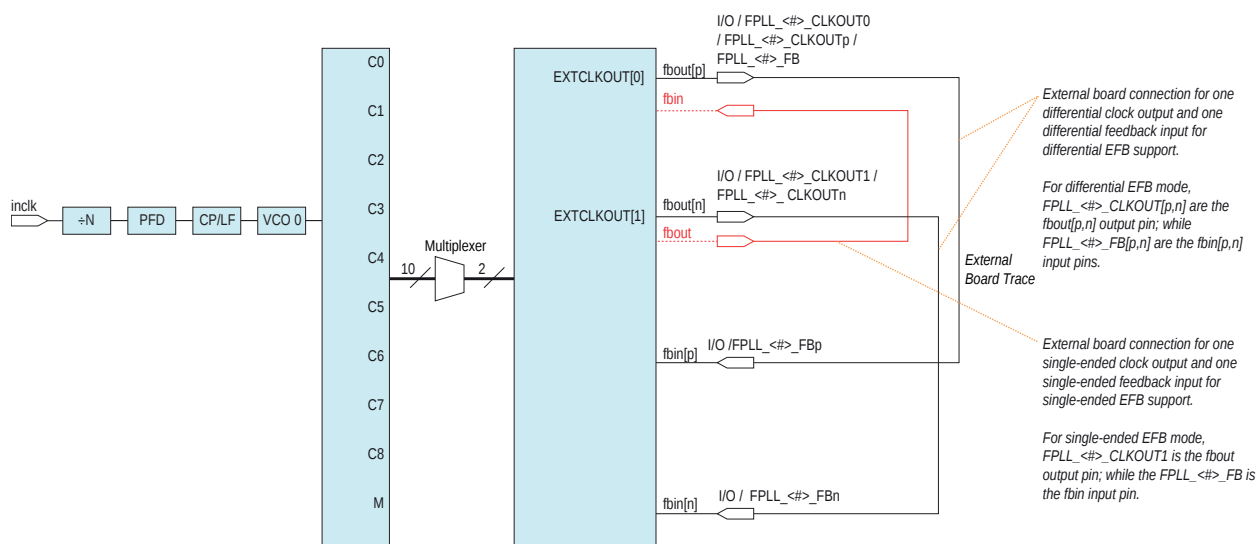
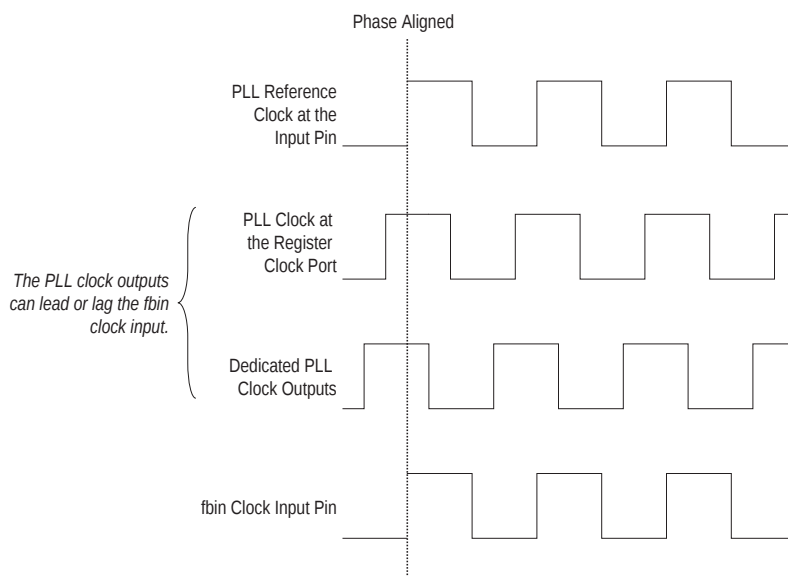


Figure 4-27: Example of Phase Relationship Between the PLL Clocks in EFB Mode



Related Information

[PLL External Clock I/O Pins](#) on page 4-19

Provides more information about PLL clock outputs.

Clock Multiplication and Division

Each Cyclone V PLL provides clock synthesis for PLL output ports using the $M/(N \times C)$ scaling factors. The input clock is divided by a pre-scale factor, N , and is then multiplied by the M feedback factor. The control loop drives the VCO to match $f_{in} \times (M/N)$.

The Quartus II software automatically chooses the appropriate scaling factors according to the input frequency, multiplication, and division values entered into the ALTERA_PLL megafunction.

Post-Scale Counter, K

A post-scale counter, K , is inserted after the VCO. When you enable the VCO post-scale counter, the counter divides the VCO frequency by two. When the K counter is bypassed, the VCO frequency goes to the output port without being divided by two.

Post-Scale Counter, C

Each output port has a unique post-scale counter, C , that divides down the output from the K counter. For multiple PLL outputs with different frequencies, the VCO is set to the least common multiple of the output frequencies that meets its frequency specifications. For example, if the output frequencies required from one PLL are 33 and 66 MHz, the Quartus II software sets the VCO to 660 MHz (the least common multiple of 33 and 66 MHz within the VCO range). Then the post-scale counters, C , scale down the VCO frequency for each output port.

Pre-Scale Counter, N and Multiply Counter, M

Each PLL has one pre-scale counter, N , and one multiply counter, M , with a range of 1 to 512 for both M and N . The N counter does not use duty-cycle control because the only purpose of this counter is to calculate frequency division. The post-scale counters have a 50% duty cycle setting. The high- and low-count values for each counter range from 1 to 256. The sum of the high- and low-count values chosen for a design selects the divide value for a given counter.

Delta-Sigma Modulator

The delta-sigma modulator (DSM) is used together with the M multiply counter to enable the PLL to operate in fractional mode. The DSM dynamically changes the M counter divide value on a cycle to cycle basis. The different M counter values allow the "average" M counter value to be a non-integer.

Fractional Mode

In fractional mode, the M counter divide value equals to the sum of the "clock high" count, "clock low" count, and the fractional value. The fractional value is equal to $K/2^X$, where K is an integer between 0 and $(2^X - 1)$, and $X = 8, 16, 24, \text{ or } 32$.

Integer Mode

For PLL operating in integer mode, M is an integer value and DSM is disabled.

Related Information**[Altera Phase-Locked Loop \(ALTERA_PLL\) Megafunction User Guide](#)**

Provides more information about PLL software support in the Quartus II software.

Programmable Duty Cycle

The programmable duty cycle allows PLLs to generate clock outputs with a variable duty cycle. This feature is supported on the PLL post-scale counters.

The duty-cycle setting is achieved by a low and high time-count setting for the post-scale counters. To determine the duty cycle choices, the Quartus II software uses the frequency input and the required multiply or divide rate.

The post-scale counter value determines the precision of the duty cycle. The precision is defined as 50% divided by the post-scale counter value. For example, if the C0 counter is 10, steps of 5% are possible for duty-cycle choices from 5% to 90%. If the PLL is in external feedback mode, set the duty cycle for the counter driving the `fbin` pin to 50%.

Combining the programmable duty cycle with programmable phase shift allows the generation of precise non-overlapping clocks.

Clock Switchover

The clock switchover feature allows the PLL to switch between two reference input clocks. Use this feature for clock redundancy or for a dual-clock domain application where a system turns on the redundant clock if the previous clock stops running. The design can perform clock switchover automatically when the clock is no longer toggling or based on a user control signal, `clkswitch`.

The following clock switchover modes are supported in Cyclone V PLLs:

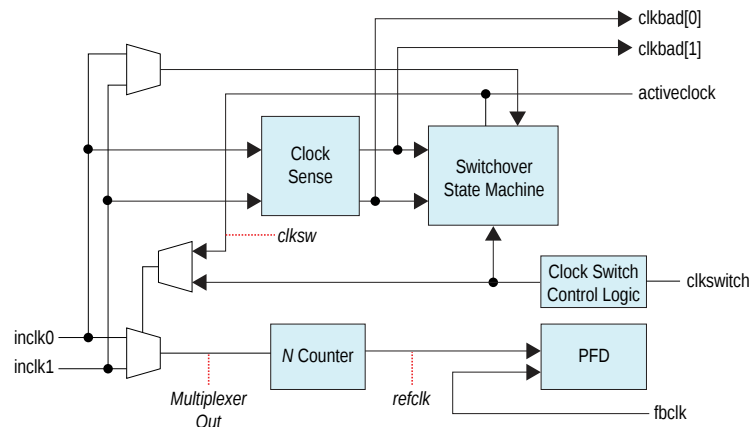
- Automatic switchover—The clock sense circuit monitors the current reference clock. If the current reference clock stops toggling, the reference clock automatically switches to `inclk0` or `inclk1` clock.
- Manual clock switchover—Clock switchover is controlled using the `clkswitch` signal. When the `clkswitch` signal goes from logic low to logic high, and stays high for at least three clock cycles, the reference clock to the PLL is switched from `inclk0` to `inclk1`, or vice-versa.
- Automatic switchover with manual override—This mode combines automatic switchover and manual clock switchover. When the `clkswitch` signal goes high, it overrides the automatic clock switchover function. As long as the `clkswitch` signal is high, further switchover action is blocked.

Automatic Switchover

Cyclone V PLLs support a fully configurable clock switchover capability.

Figure 4-28: Automatic Clock Switchover Circuit Block Diagram

This figure shows a block diagram of the automatic switchover circuit built into the PLL.



When the current reference clock is not present, the clock sense block automatically switches to the backup clock for PLL reference. You can select a clock source as the backup clock by connecting it to the `inclk1` port of the PLL in your design.

The clock switchover circuit sends out three status signals—`clkbad[0]`, `clkbad[1]`, and `activeclock`—from the PLL to implement a custom switchover circuit in the logic array.

In automatic switchover mode, the `clkbad[0]` and `clkbad[1]` signals indicate the status of the two clock inputs. When they are asserted, the clock sense block detects that the corresponding clock input has stopped toggling. These two signals are not valid if the frequency difference between `inclk0` and `inclk1` is greater than 20%.

The `activeclock` signal indicates which of the two clock inputs (`inclk0` or `inclk1`) is being selected as the reference clock to the PLL. When the frequency difference between the two clock inputs is more than 20%, the `activeclock` signal is the only valid status signal.

Note: Glitches in the input clock may cause the frequency difference between the input clocks to be more than 20%.

Use the switchover circuitry to automatically switch between `inclk0` and `inclk1` when the current reference clock to the PLL stops toggling. You can switch back and forth between `inclk0` and `inclk1` any number of times when one of the two clocks fails and the other clock is available.

For example, in applications that require a redundant clock with the same frequency as the reference clock, the switchover state machine generates a signal (`clksw`) that controls the multiplexer select input. In this case, `inclk1` becomes the reference clock for the PLL.

When using automatic clock switchover mode, the following requirements must be satisfied:

- Both clock inputs must be running.
- The period of the two clock inputs can differ by no more than 20%.

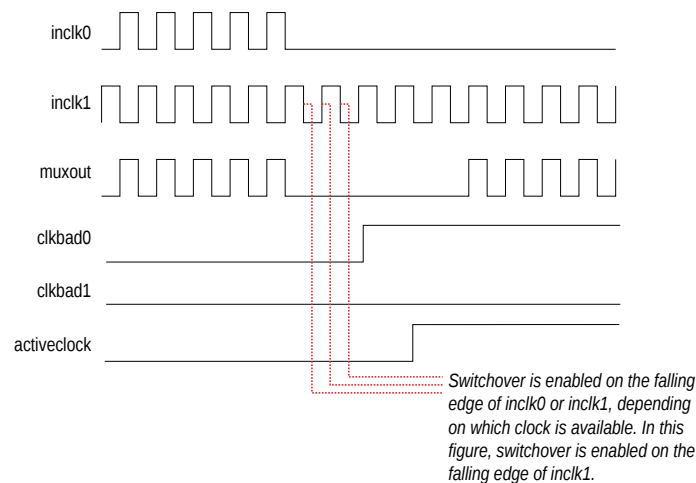
If the current clock input stops toggling while the other clock is also not toggling, switchover is not initiated and the `clkbad[0..1]` signals are not valid. If both clock inputs are not the same frequency, but their

period difference is within 20%, the clock sense block detects when a clock stops toggling. However, the PLL may lose lock after the switchover is completed and needs time to relock.

Note: Altera recommends resetting the PLL using the `areset` signal to maintain the phase relationships between the PLL input and output clocks when using clock switchover.

Figure 4-29: Automatic Switchover After Loss of Clock Detection

This figure shows an example waveform of the switchover feature in automatic switchover mode. In this example, the `inclk0` signal is stuck low. After the `inclk0` signal is stuck at low for approximately two clock cycles, the clock sense circuitry drives the `clkbad[0]` signal high. Since the reference clock signal is not toggling, the switchover state machine controls the multiplexer through the `clkswitch` signal to switch to the backup clock, `inclk1`.



Automatic Switchover with Manual Override

In automatic switchover with manual override mode, you can use the `clkswitch` signal for user- or system-controlled switch conditions. You can use this mode for same-frequency switchover, or to switch between inputs of different frequencies.

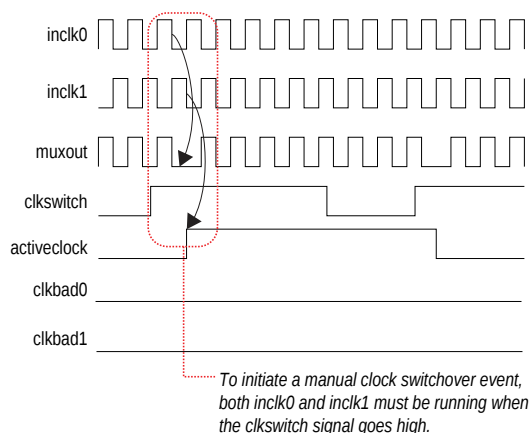
For example, if `inclk0` is 66 MHz and `inclk1` is 200 MHz, you must control switchover using the `clkswitch` signal. The automatic clock-sense circuitry cannot monitor clock input (`inclk0` and `inclk1`) frequencies with a frequency difference of more than 100% (2×).

This feature is useful when the clock sources originate from multiple cards on the backplane, requiring a system-controlled switchover between the frequencies of operation.

You must choose the backup clock frequency and set the M, N, C, and K counters so that the VCO operates within the recommended operating frequency range. The ALTERA_PLL MegaWizard Plug-in Manager notifies you if a given combination of `inclk0` and `inclk1` frequencies cannot meet this requirement.

Figure 4-30: Clock Switchover Using the `clkswitch` (Manual) Control

This figure shows a clock switchover waveform controlled by the `clkswitch` signal. In this case, both clock sources are functional and `inclk0` is selected as the reference clock; the `clkswitch` signal goes high, which starts the switchover sequence. On the falling edge of `inclk0`, the counter's reference clock, `muxout`, is gated off to prevent clock glitching. On the falling edge of `inclk1`, the reference clock multiplexer switches from `inclk0` to `inclk1` as the PLL reference. The `activeclock` signal changes to indicate the clock which is currently feeding the PLL.



In automatic override with manual switchover mode, the `activeclock` signal mirrors the `clkswitch` signal. Since both clocks are still functional during the manual switch, neither `clkbad` signal goes high. Because the switchover circuit is positive-edge sensitive, the falling edge of the `clkswitch` signal does not cause the circuit to switch back from `inclk1` to `inclk0`. When the `clkswitch` signal goes high again, the process repeats.

The `clkswitch` signal and automatic switch work only if the clock being switched to is available. If the clock is not available, the state machine waits until the clock is available.

Related Information

[Altera Phase-Locked Loop \(ALTERA_PLL\) Megafunction User Guide](#)

Provides more information about PLL software support in the Quartus II software.

Manual Clock Switchover

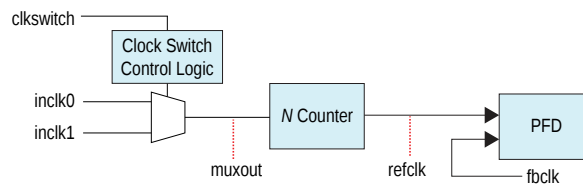
In manual clock switchover mode, the `clkswitch` signal controls whether `inclk0` or `inclk1` is selected as the input clock to the PLL. By default, `inclk0` is selected.

A clock switchover event is initiated when the `clkswitch` signal transitions from logic low to logic high, and being held high for at least three `inclk` cycles.

You must bring the `clkswitch` signal back low again to perform another switchover event. If you do not require another switchover event, you can leave the `clkswitch` signal in a logic high state after the initial switch.

Pulsing the `clkswitch` signal high for at least three `inclk` cycles performs another switchover event.

If `inclk0` and `inclk1` are different frequencies and are always running, the `clkswitch` signal minimum high time must be greater than or equal to three of the slower frequency `inclk0` and `inclk1` cycles.

Figure 4-31: Manual Clock Switchover Circuitry in Cyclone V PLLs

You can delay the clock switchover action by specifying the switchover delay in the `ALTERA_PLL` megafunction. When you specify the switchover delay, the `clkswitch` signal must be held high for at least three `inclk` cycles plus the number of the delay cycles that has been specified to initiate a clock switchover.

Related Information

[Altera Phase-Locked Loop \(ALTERA_PLL\) Megafunction User Guide](#)

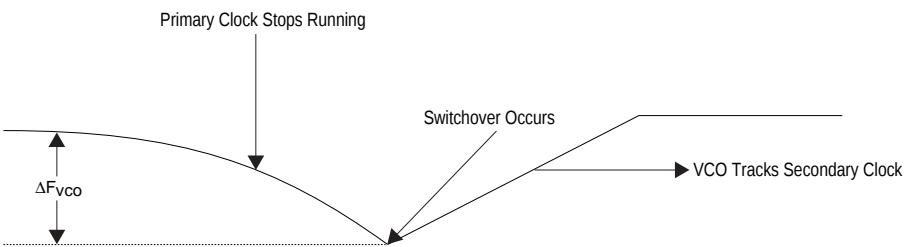
Provides more information about PLL software support in the Quartus II software.

Guidelines

When implementing clock switchover in Cyclone V PLLs, use the following guidelines:

- Automatic clock switchover requires that the `inclk0` and `inclk1` frequencies be within 20% of each other. Failing to meet this requirement causes the `clkbad[0]` and `clkbad[1]` signals to not function properly.
- When using manual clock switchover, the difference between `inclk0` and `inclk1` can be more than 100% (2×). However, differences in frequency, phase, or both, of the two clock sources will likely cause the PLL to lose lock. Resetting the PLL ensures that you maintain the correct phase relationships between the input and output clocks.
- Both `inclk0` and `inclk1` must be running when the `clkswitch` signal goes high to initiate the manual clock switchover event. Failing to meet this requirement causes the clock switchover to not function properly.
- Applications that require a clock switchover feature and a small frequency drift must use a low-bandwidth PLL. When referencing input clock changes, the low-bandwidth PLL reacts more slowly than a high-bandwidth PLL. When switchover happens, a low-bandwidth PLL propagates the stopping of the clock to the output more slowly than a high-bandwidth PLL. However, be aware that the low-bandwidth PLL also increases lock time.
- After a switchover occurs, there may be a finite resynchronization period for the PLL to lock onto a new clock. The time it takes for the PLL to relock depends on the PLL configuration.
- The phase relationship between the input clock to the PLL and the output clock from the PLL is important in your design. Assert `areset` for at least 10 ns after performing a clock switchover. Wait for the locked signal to go high and be stable before re-enabling the output clocks from the PLL.
- The VCO frequency gradually decreases when the current clock is lost and then increases as the VCO locks on to the backup clock, as shown in the following figure.

Figure 4-32: VCO Switchover Operating Frequency



PLL Reconfiguration and Dynamic Phase Shift

For more information about PLL reconfiguration and dynamic phase shifting, refer to AN661.

Related Information
[AN661: Implementing Fractional PLL Reconfiguration with ALTERA_PLL and ALTERA_PLL_RECONFIG Megafunctions](#)

Document Revision History

Date	Version	Changes
May 2013	2013.05.06	<ul style="list-style-type: none">Added link to the known document issues in the Knowledge Base.Updated PCLK clock sources in hierarchical clock networks in each spine clock per quadrant diagram.Added PCLK networks in clock network sources section.Updated dedicated clock input pins in clock network sources section.Added descriptions for PLLs located in a strip.Added information on PLL physical counters.Updated the fractional PLL architecture diagram to add dedicated <code>refclk</code> input port and connections.Updated PLL support for EFB mode.Updated the scaling factors for PLL output ports.Updated the fractional value for PLL in fractional mode.Moved all links to the Related Information section of respective topics for easy reference.Reorganized content.

Date	Version	Changes
December 2012	2012.12.28	<ul style="list-style-type: none"> Added note to indicate that the figures shown are the top view of the silicon die. Removed DPA support. Updated clock resources table. Updated diagrams for GCLK, RCLK, and PCLK networks. Updated diagram for clock sources per quadrant. Updated dual-regional clock region for Cyclone V SoC devices support. Restructured and updated tables for clock input pin connectivity to the GCLK and RCLK networks. Added tables for clock input pin connectivity to the GCLK and RCLK networks for Cyclone V SoC devices. Updated PCLK control block diagram. Updated information on clock power down. Added diagram for PLL physical counter orientation. Updated PLL locations diagrams. Updated fractional PLL high-level block diagram. Removed information on pfdena PLL control signal. Removed information on PLL Compensation assignment in the Quartus II software. Updated the fractional value for PLL in fractional mode. Reorganized content and updated template.
June 2012	2.0	<ul style="list-style-type: none"> Restructured chapter. Updated Figure 4-4, Figure 4-6, Figure 4-7, Figure 4-11, Figure 4-13, Figure 4-15, Figure 4-16, Figure 4-17, Figure 4-19, and Figure 4-20. Updated Table 4-2, Table 4-3, and Table 4-5. Added “Clock Regions”, “Clock Network Sources”, “Clock Output Connections”, “Clock Enable Signals”, “PLL Control Signals”, “Clock Multiplication and Division”, “Programmable Duty Cycle”, “Clock Switchover”, and “PLL Reconfiguration and Dynamic Phase Shift” sections.
February 2012	1.1	Updated Table 4-2.
October 2011	1.0	Initial release.

2013.06.21

CV-52005



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This chapter provides details about the features of the Cyclone V I/O elements (IOEs) and how the IOEs work in compliance with current and emerging I/O standards and requirements.

The Cyclone V I/Os support the following features:

- Single-ended, non-voltage-referenced, and voltage-referenced I/O standards
- Low-voltage differential signaling (LVDS), RSDS, mini-LVDS, HSTL, HSUL, and SSTL I/O standards
- Serializer/deserializer (SERDES)
- Programmable output current strength
- Programmable slew-rate
- Programmable bus-hold
- Programmable pull-up resistor
- Programmable pre-emphasis
- Programmable I/O delay
- Programmable voltage output differential (V_{OD})
- Open-drain output
- On-chip series termination (R_S OCT) with and without calibration
- On-chip parallel termination (R_T OCT)
- On-chip differential termination (R_D OCT)
- High-speed differential I/O support

Note: The information in this chapter is applicable to all Cyclone V variants, unless noted otherwise.

Related Information

[Cyclone V Device Handbook: Known Issues](#)

Lists the planned updates to the *Cyclone V Device Handbook* chapters.

I/O Resources Per Package for Cyclone V Devices

The following package plan tables for the different Cyclone V variants list the maximum I/O resources available for each package.

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ISO
9001:2008
Registered



Table 5-1: Package Plan for Cyclone V E Devices—Preliminary

Member Code	M383	M484	U324	F256	U484	F484	F672	F896
	GPIO	GPIO	GPIO	GPIO	GPIO	GPIO	GPIO	GPIO
A2	223	—	176	128	224	224	—	—
A4	223	—	176	128	224	224	—	—
A5	175	—	—	—	224	240	—	—
A7	—	240	—	—	240	240	336	480
A9	—	—	—	—	240	224	336	480

Table 5-2: Package Plan for Cyclone V GX Devices—Preliminary

Member Code	M301		M383		M484		U324		U484		F484		F672		F896		F1152	
	GPIO	XCVR	GPIO	XCVR	GPIO	XCVR	GPIO	XCVR	GPIO	XCVR	GPIO	XCVR	GPIO	XCVR	GPIO	XCVR	GPIO	XCVR
C3	—	—	—	—	—	—	144	3	208	3	208	3	—	—	—	—	—	—
C4	129	4	175	6	—	—	—	—	224	6	240	6	336	6	—	—	—	—
C5	129	4	175	6	—	—	—	—	224	6	240	6	336	6	—	—	—	—
C7	—	—	—	—	240	3	—	—	240	6	240	6	336	9	480	9	—	—
C9	—	—	—	—	—	—	—	—	240	5	224	6	336	9	480	12	560	12

Table 5-3: Package Plan for Cyclone V GT Devices—Preliminary

Member Code	M301		M383		M484		U484		F484		F672		F896		F1152	
	GPIO	XCVR	GPIO	XCVR	GPIO	XCVR	GPIO	XCVR	GPIO	XCVR	GPIO	XCVR	GPIO	XCVR	GPIO	XCVR
D5	129	4	175	6	—	—	224	6	240	6	336	6	—	—	—	—
D7	—	—	—	—	240	3	240	6	240	6	336	9	480	9	—	—
D9	—	—	—	—	—	—	240	5	224	6	336	9	480	12	560	12

Table 5-4: Package Plan for Cyclone V SE Devices—Preliminary

Member Code	U484		U672		F896	
	FPGA GPIO	HPS I/O	FPGA GPIO	HPS I/O	FPGA GPIO	HPS I/O
A2	66	151	145	181	—	—
A4	66	151	145	181	—	—
A5	66	151	145	181	288	181
A6	66	151	145	181	288	181

Table 5-5: Package Plan for Cyclone V SX Devices—Preliminary

Member Code	U672			F896		
	FPGA GPIO	HPS I/O	XCVR	FPGA GPIO	HPS I/O	XCVR
C2	145	181	6	—	—	—
C4	145	181	6	—	—	—
C5	145	181	6	288	181	9
C6	145	181	6	288	181	9

Table 5-6: Package Plan for Cyclone V ST Devices—Preliminary

Member Code	F896		
	FPGA GPIO	HPS I/O	XCVR
D5	288	181	9
D6	288	181	9

For more information about each device variant, refer to the device overview.

Related Information

[Cyclone V Device Overview](#)

I/O Vertical Migration for Cyclone V Devices

Figure 5-1: Vertical Migration Capability Across Cyclone V Device Packages and Densities—Preliminary

The arrows indicate the vertical migration paths. The devices included in each vertical migration path are shaded. You can also migrate your design across device densities in the same package option if the devices have the same dedicated pins, configuration pins, and power pins.

Variant	Member Code	Package										
		M301	M383	M484	F256	U324	U484	F484	U672	F672	F896	F1152
Cyclone V E	A2		↕		↕	↕	↕	↕				
	A4		↕		↕	↕	↕	↕				
	A5		↕				↕	↕				
	A7						↕	↕		↕	↕	
	A9						↕	↕		↕	↕	
Cyclone V GX	C3						↕	↕		↕		
	C4	↕	↕				↕	↕		↕		
	C5	↕	↕				↕	↕		↕		
	C7						↕	↕		↕	↕	
	C9						↕	↕		↕	↕	
Cyclone V GT	D5						↕	↕		↕	↕	
	D7						↕	↕		↕	↕	
	D9						↕	↕		↕	↕	
Cyclone V SE	A2						↕		↕			
	A4						↕		↕			
	A5						↕		↕		↕	
	A6						↕		↕		↕	
Cyclone V SX	C2								↕			
	C4								↕			
	C5								↕		↕	
	C6								↕		↕	
Cyclone V ST	D5										↕	
	D6										↕	

You can achieve the vertical migration shaded in red if you use only up to 175 GPIOs. This migration path is not shown in the Quartus II software Pin Migration View.

Note: To verify the pin migration compatibility, use the Pin Migration View window in the Quartus II software Pin Planner.

Related Information

- [Verifying Pin Migration Compatibility](#) on page 5-5
- [I/O Management chapter, Quartus II Handbook](#)
Provides more information about vertical I/O migrations.

Verifying Pin Migration Compatibility

You can use the Pin Migration View window in the Quartus II software Pin Planner to assist you in verifying whether your pin assignments migrate to a different device successfully. You can vertically migrate to a device with a different density while using the same device package, or migrate between packages with different densities and ball counts.

1. Open **Assignments > Pin Planner** and create pin assignments.
2. If necessary, perform one of the following options to populate the Pin Planner with the node names in the design:
 - Analysis & Elaboration
 - Analysis & Synthesis
 - Fully compile the design
3. Then, on the menu, click **View > Pin Migration View**.
4. To select or change migration devices:
 - a. Click **Device** to open the **Device** dialog box.
 - b. Under **Migration compatibility** click **Migration Devices**.
5. To show more information about the pins:
 - a. Right-click anywhere in the **Pin Migration View** window and select **Show Columns**.
 - b. Then, click the pin feature you want to display.
6. If you want to view only the pins, in at least one migration device, that have a different feature than the corresponding pin in the migration result, turn on **Show migration differences**.
7. Click **Pin Finder** to open the **Pin Finder** dialog box and find and highlight pins with specific functionality. If you want to view only the pins found and highlighted by the most recent query in the **Pin Finder** dialog box, turn on **Show only highlighted pins**.
8. To export the pin migration information to a Comma-Separated Value File (.csv), click **Export**.

Related Information

- [I/O Vertical Migration for Cyclone V Devices](#) on page 5-4
- [I/O Management chapter, Quartus II Handbook](#)
Provides more information about vertical I/O migrations.

I/O Standards Support in Cyclone V Devices

This section lists the I/O standards supported in the FPGA I/Os and HPS I/Os of Cyclone V devices, the typical power supply values for each I/O standard, and the MultiVolt I/O interface feature.

I/O Standards Support for FPGA I/O in Cyclone V Devices

Table 5-7: Supported I/O Standards in FPGA I/O for Cyclone V Devices

I/O Standard	Standard Support
3.3 V LVTTTL/3.3 V LVCMOS	JESD8-B

I/O Standard	Standard Support
3.0 V LVTTTL/3.0 V LVCMOS	JESD8-B
3.0 V PCI ⁽⁶⁾	PCI Rev. 2.2
3.0 V PCI-X ⁽⁷⁾	PCI-X Rev. 1.0
2.5 V LVCMOS	JESD8-5
1.8 V LVCMOS	JESD8-7
1.5 V LVCMOS	JESD8-11
1.2 V LVCMOS	JESD8-12
SSTL-2 Class I	JESD8-9B
SSTL-2 Class II	JESD8-9B
SSTL-18 Class I	JESD8-15
SSTL-18 Class II	JESD8-15
SSTL-15 Class I	—
SSTL-15 Class II	—
1.8 V HSTL Class I	JESD8-6
1.8 V HSTL Class II	JESD8-6
1.5 V HSTL Class I	JESD8-6
1.5 V HSTL Class II	JESD8-6
1.2 V HSTL Class I	JESD8-16A
1.2 V HSTL Class II	JESD8-16A
Differential SSTL-2 Class I	JESD8-9B
Differential SSTL-2 Class II	JESD8-9B
Differential SSTL-18 Class I	JESD8-15
Differential SSTL-18 Class II	JESD8-15
Differential SSTL-15 Class I	—
Differential SSTL-15 Class II	—
Differential 1.8 V HSTL Class I	JESD8-6
Differential 1.8 V HSTL Class II	JESD8-6
Differential 1.5 V HSTL Class I	JESD8-6
Differential 1.5 V HSTL Class II	JESD8-6
Differential 1.2 V HSTL Class I	JESD8-16A
Differential 1.2 V HSTL Class II	JESD8-16A

⁽⁶⁾ 3.3 V PCI I/O standard is not supported.

⁽⁷⁾ 3.3 V PCI-X I/O standard is not supported. PCI-X does not meet the PCI-X I–V curve requirement at the linear region.

I/O Standard	Standard Support
LVDS	ANSI/TIA/EIA-644
RSDS ⁽⁸⁾	—
Mini-LVDS ⁽⁹⁾	—
LVPECL	—
SLVS	JESD8-13
Sub-LVDS	—
HiSpi	—
SSTL-15	JESD79-3D
SSTL-135	—
SSTL-125	—
HSUL-12	—
Differential SSTL-15	JESD79-3D
Differential SSTL-135	—
Differential SSTL-125	—
Differential HSUL-12	—

I/O Standards Support for HPS I/O in Cyclone V Devices

Table 5-8: Supported I/O Standards in HPS I/O for Cyclone V SE, SX, and ST Devices

I/O Standard	Standard Support	HPS Column I/O	HPS Row I/O
3.3 V LVTTTL/3.3 V LVCMOS	JESD8-B	Yes	—
3.0 V LVTTTL/3.0 V LVCMOS	JESD8-B	Yes	—
2.5 V LVCMOS	JESD8-5	Yes	—
1.8 V LVCMOS	JESD8-7	Yes	Yes
1.5 V LVCMOS	JESD8-11	Yes	—
SSTL-18 Class I	JESD8-15	—	Yes
SSTL-18 Class II	JESD8-15	—	Yes
SSTL-15 Class I	—	—	Yes
SSTL-15 Class II	—	—	Yes
1.5 V HSTL Class I	JESD8-6	Yes	—
1.5 V HSTL Class II	JESD8-6	Yes	—

⁽⁸⁾ The Cyclone V devices support true RSDS output standard with data rates of up to 230 Mbps using true LVDS output buffer types on all I/O banks.

⁽⁹⁾ The Cyclone V devices support true mini-LVDS output standard with data rates of up to 340 Mbps using true LVDS output buffer types on all I/O banks.

I/O Standard	Standard Support	HPS Column I/O	HPS Row I/O
SSTL-135	—	—	Yes
SSTL-125	—	—	Yes
HSUL-12	—	—	Yes

I/O Standards Voltage Levels in Cyclone V Devices

Table 5-9: Cyclone V I/O Standards Voltage Levels

This table lists the typical power supplies for each supported I/O standards in Cyclone V devices.

I/O Standard	V _{CCIO} (V)		V _{CCPD} (V) (Pre-Driver Voltage)	V _{REF} (V) (Input Ref Voltage)	V _{TT} (V) (Board Termination Voltage)
	Input ⁽¹⁰⁾	Output			
3.3 V LVTTTL/3.3 V LVCMOS	3.3/3.0/2.5	3.3	3.3	—	—
3.0 V LVTTTL/3.0 V LVCMOS	3.0/2.5	3.0	3.0	—	—
3.0 V PCI	3.0	3.0	3.0	—	—
3.0 V PCI-X	3.0	3.0	3.0	—	—
2.5 V LVCMOS	3.0/2.5	2.5	2.5	—	—
1.8 V LVCMOS	1.8/1.5	1.8	2.5	—	—
1.5 V LVCMOS	1.8/1.5	1.5	2.5	—	—
1.2 V LVCMOS	1.2	1.2	2.5	—	—
SSTL-2 Class I	V _{CCPD}	2.5	2.5	1.25	1.25
SSTL-2 Class II	V _{CCPD}	2.5	2.5	1.25	1.25
SSTL-18 Class I	V _{CCPD}	1.8	2.5	0.9	0.9
SSTL-18 Class II	V _{CCPD}	1.8	2.5	0.9	0.9
SSTL-15 Class I	V _{CCPD}	1.5	2.5	0.75	0.75
SSTL-15 Class II	V _{CCPD}	1.5	2.5	0.75	0.75
1.8 V HSTL Class I	V _{CCPD}	1.8	2.5	0.9	0.9
1.8 V HSTL Class II	V _{CCPD}	1.8	2.5	0.9	0.9
1.5 V HSTL Class I	V _{CCPD}	1.5	2.5	0.75	0.75
1.5 V HSTL Class II	V _{CCPD}	1.5	2.5	0.75	0.75
1.2 V HSTL Class I	V _{CCPD}	1.2	2.5	0.6	0.6
1.2 V HSTL Class II	V _{CCPD}	1.2	2.5	0.6	0.6

⁽¹⁰⁾ Input for the SSTL, HSTL, Differential SSTL, Differential HSTL, LVDS, RSDS, Mini-LVDS, LVPECL, HSUL, and Differential HSUL are powered by V_{CCPD}

I/O Standard	V_{CCIO} (V)		V_{CCPD} (V) (Pre-Driver Voltage)	V_{REF} (V) (Input Ref Voltage)	V_{TT} (V) (Board Termination Voltage)
	Input ⁽¹⁰⁾	Output			
Differential SSTL-2 Class I	V_{CCPD}	2.5	2.5	—	1.25
Differential SSTL-2 Class II	V_{CCPD}	2.5	2.5	—	1.25
Differential SSTL-18 Class I	V_{CCPD}	1.8	2.5	—	0.9
Differential SSTL-18 Class II	V_{CCPD}	1.8	2.5	—	0.9
Differential SSTL-15 Class I	V_{CCPD}	1.5	2.5	—	0.75
Differential SSTL-15 Class II	V_{CCPD}	1.5	2.5	—	0.75
Differential 1.8 V HSTL Class I	V_{CCPD}	1.8	2.5	—	0.9
Differential 1.8 V HSTL Class II	V_{CCPD}	1.8	2.5	—	0.9
Differential 1.5 V HSTL Class I	V_{CCPD}	1.5	2.5	—	0.75
Differential 1.5 V HSTL Class II	V_{CCPD}	1.5	2.5	—	0.75
Differential 1.2 V HSTL Class I	V_{CCPD}	1.2	2.5	—	0.6
Differential 1.2 V HSTL Class II	V_{CCPD}	1.2	2.5	—	0.6
LVDS	V_{CCPD}	2.5	2.5	—	—
RSDS	V_{CCPD}	2.5	2.5	—	—
Mini-LVDS	V_{CCPD}	2.5	2.5	—	—
LVPECL (Differential clock input only)	V_{CCPD}	—	2.5	—	—
SLVS (Input only)	V_{CCPD}	—	2.5	—	—
Sub-LVDS (input only)	V_{CCPD}	—	2.5	—	—
HiSpi (input only)	V_{CCPD}	—	2.5	—	—

⁽¹⁰⁾ Input for the SSTL, HSTL, Differential SSTL, Differential HSTL, LVDS, RSDS, Mini-LVDS, LVPECL, HSUL, and Differential HSUL are powered by V_{CCPD}

I/O Standard	V_{CCIO} (V)		V_{CCPD} (V) (Pre-Driver Voltage)	V_{REF} (V) (Input Ref Voltage)	V_{TT} (V) (Board Termination Voltage)
	Input ⁽¹⁰⁾	Output			
SSTL-15	V_{CCPD}	1.5	2.5	0.75	Typically does not require board termination
SSTL-135	V_{CCPD}	1.35	2.5	0.675	
SSTL-125	V_{CCPD}	1.25	2.5	0.625	
HSUL-12	V_{CCPD}	1.2	2.5	0.6	
Differential SSTL-15	V_{CCPD}	1.5	2.5	—	Typically does not require board termination
Differential SSTL-135	V_{CCPD}	1.35	2.5	—	
Differential SSTL-125	V_{CCPD}	1.25	2.5	—	
Differential HSUL-12	V_{CCPD}	1.2	2.5	—	

Related Information

[MultiVolt I/O Interface in Cyclone V Devices](#) on page 5-10

MultiVolt I/O Interface in Cyclone V Devices

The MultiVolt I/O interface feature allows Cyclone V devices in all packages to interface with systems of different supply voltages.

Table 5-10: MultiVolt I/O Support in Cyclone V Devices

V_{CCIO} (V)	V_{CCPD} (V)	Input Signal (V)	Output Signal (V)
1.2	2.5	1.2	1.2
1.25	2.5	1.25	1.25
1.35	2.5	1.35	1.35
1.5	2.5	1.5, 1.8	1.5
1.8	2.5	1.5, 1.8	1.8
2.5	2.5	2.5, 3.0	2.5
3.0	3.0	2.5, 3.0, 3.3	3.0
3.3	3.3	2.5, 3.0, 3.3	3.3

The pin current may be slightly higher than the default value. Verify that the V_{OL} maximum and V_{OH} minimum voltages of the driving device do not violate the applicable V_{IL} maximum and V_{IH} minimum voltage specifications of the Cyclone V device.

The V_{CCPD} power pins must be connected to a 2.5 V, 3.0 V, or 3.3 V power supply. Using these power pins to supply the pre-driver power to the output buffers increases the performance of the output pins.

⁽¹⁰⁾ Input for the SSTL, HSTL, Differential SSTL, Differential HSTL, LVDS, RSFS, Mini-LVDS, LVPECL, HSUL, and Differential HSUL are powered by V_{CCPD}

Note: If the input signal is 3.0 V or 3.3 V, Altera recommends that you use a clamping diode on the I/O pins.

Related Information

[I/O Standards Voltage Levels in Cyclone V Devices](#) on page 5-8

I/O Design Guidelines for Cyclone V Devices

There are several considerations that require your attention to ensure the success of your designs. Unless noted otherwise, these design guidelines apply to all variants of this device family.

Mixing Voltage-Referenced and Non-Voltage-Referenced I/O Standards

Each I/O bank can simultaneously support multiple I/O standards. The following sections provide guidelines for mixing non-voltage-referenced and voltage-referenced I/O standards in the devices.

Non-Voltage-Referenced I/O Standards

Each Cyclone V I/O bank has its own V_{CCIO} pins and supports only one V_{CCIO} of 1.2, 1.25, 1.35, 1.5, 1.8, 2.5, 3.0, or 3.3 V. An I/O bank can simultaneously support any number of input signals with different I/O standard assignments if the I/O standards support the V_{CCIO} level of the I/O bank.

For output signals, a single I/O bank supports non-voltage-referenced output signals that drive at the same voltage as V_{CCIO} . Because an I/O bank can only have one V_{CCIO} value, it can only drive out the value for non-voltage-referenced signals.

For example, an I/O bank with a 2.5 V V_{CCIO} setting can support 2.5 V standard inputs and outputs, and 3.0 V LVCMOS inputs only.

Voltage-Referenced I/O Standards

To accommodate voltage-referenced I/O standards:

- Each Cyclone V I/O bank contains a dedicated V_{REF} pin.
- Each bank can have only a single V_{CCIO} voltage level and a single voltage reference (V_{REF}) level.

An I/O bank featuring single-ended or differential standards can support different voltage-referenced standards if the V_{CCIO} and V_{REF} are the same levels.

For performance reasons, voltage-referenced input standards use their own V_{CCPD} level as the power source. This feature allows you to place voltage-referenced input signals in an I/O bank with a V_{CCIO} of 2.5 V or below. For example, you can place HSTL-15 input pins in an I/O bank with 2.5 V V_{CCIO} . However, the voltage-referenced input with R_T OCT enabled requires the V_{CCIO} of the I/O bank to match the voltage of the input standard. R_T OCT cannot be supported for the HSTL-15 I/O standard when V_{CCIO} is 2.5 V.

Voltage-referenced bidirectional and output signals must be the same as the V_{CCIO} voltage of the I/O bank. For example, you can place only SSTL-2 output pins in an I/O bank with a 2.5 V V_{CCIO} .

Mixing Voltage-Referenced and Non-Voltage Referenced I/O Standards

An I/O bank can support voltage-referenced and non-voltage-referenced pins by applying each of the rule sets individually.

Examples:

- An I/O bank can support SSTL-18 inputs and outputs, and 1.8 V inputs and outputs with a 1.8 V V_{CCIO} and a 0.9 V V_{REF} .
- An I/O bank can support 1.5 V standards, 1.8 V inputs (but not outputs), and 1.5 V HSTL I/O standards with a 1.5 V V_{CCIO} and 0.75 V V_{REF} .

PLLs and Clocking

The Cyclone V device family supports fractional PLLs on each side of the device. You can use fractional PLLs to reduce the number of oscillators and the clock pins used in the FPGA by synthesizing multiple clock frequencies from a single reference clock source.

The corner fractional PLLs can drive the LVDS receiver and driver channels. However, the clock tree network cannot cross over to different I/O regions. For example, the top left corner fractional PLL cannot cross over to drive the LVDS receiver and driver channels on the top right I/O bank. The Quartus II compiler automatically checks the design and issues an error message if the guidelines are not followed.

Related Information

- [High-Speed Differential I/O Locations](#) on page 5-51
PLL locations that are available for each device.
- [Guideline: Use PLLs in Integer PLL Mode for LVDS](#) on page 5-12

Guideline: Use PLLs in Integer PLL Mode for LVDS

To drive the LVDS channels, you must use the PLLs in integer PLL mode. The corner PLLs can drive the LVDS receiver and transmitter channels.

Guideline: Reference Clock Restriction for LVDS Application

You must use the dedicated reference clock pin of the same I/O bank used by the data channel. For I/O banks without a dedicated reference clock pin, use the reference clock pin in the I/O bank listed in the following table.

Table 5-11: Reference Clock Pin for I/O Bank Without Dedicated Reference Clock Pin

Device Variant	Member Code	Data Channel I/O Bank	Reference Clock Pin I/O Bank
Cyclone V E	A2, A4	Banks using bottom right PLL	4A
		Banks using bottom left PLL	3B
		Banks using top right PLL	7A
		Banks using top left PLL	8A
	A5, A9	3A	3B
		5A	5B
	A7	5A	5B
Cyclone V GX	C4, C5, C9	3A	3B
		5A	5B
	C3, C7	5A	5B
Cyclone V GT	D5, D9	3A	3B
		5A	5B
	D7	3A	3B
Cyclone V SE	A2, A4	3A	3B
		5A	5B
	A5, A6	5A	5B
Cyclone V SX	C2, C4	3A	3B
		5A	5B
	C5, C6	5A	5B
Cyclone V ST	D5, D6	5A	5B

Guideline: Using LVDS Differential Channels

If you use LVDS channels, adhere to the following guidelines.

LVDS Channel Driving Distance

Each PLL can drive all the LVDS channels in the entire quadrant.

Using Both Corner PLLs

You can use both corner PLLs to drive LVDS channels simultaneously. You can use a corner PLL to drive all the transmitter channels and the other corner PLL to drive all the receiver channels in the same I/O bank.

Both corner PLLs can drive duplex channels in the same I/O bank if the channels that are driven by each PLL are not interleaved. You do not require separation between the groups of channels that are driven by both corner PLLs.

Note: The figures in this section show guidelines for using corner PLLs but do not necessarily represent the exact locations of the high-speed LVDS I/O banks.

Figure 5-2: Corner PLLs Driving LVDS Differential I/Os in the Same Bank

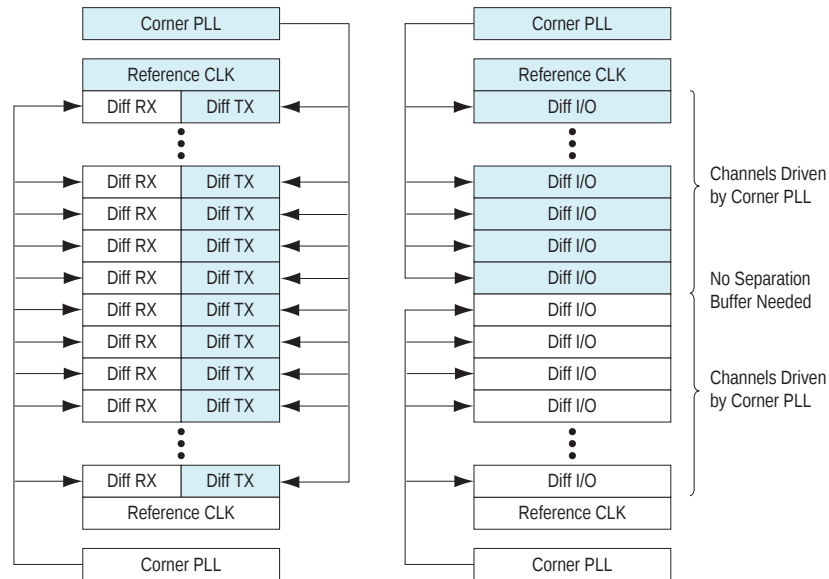
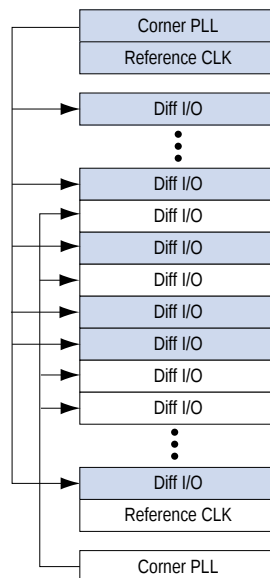


Figure 5-3: Invalid Placement of Differential I/Os Due to Interleaving of Channels Driven by the Corner PLLs



Related Information

[Clock Networks and PLLs in Cyclone V Devices](#) on page 4-1

LVDS Interface with External PLL Mode

The MegaWizard Plug-In Manager provides an option for implementing the LVDS interface with the **Use External PLL** option. With this option enabled you can control the PLL settings, such as dynamically reconfiguring the PLL to support different data rates, dynamic phase shift, and other settings. You must also instantiate the an Altera_PLL megafunction to generate the various clock and load enable signals.

If you enable the **Use External PLL** option with the ALTLVDS transmitter and receiver, the following signals are required from the Altera_PLL megafunction:

- Serial clock input to the SERDES of the ALTLVDS transmitter and receiver
- Load enable to the SERDES of the ALTLVDS transmitter and receiver
- Parallel clock used to clock the transmitter FPGA fabric logic and parallel clock used for the receiver rx_syncclock port and receiver FPGA fabric logic
- Asynchronous PLL reset port of the ALTLVDS receiver

Altera_PLL Signal Interface with ALTLVDS Megafunction

Table 5-12: Signal Interface Between Altera_PLL and ALTLVDS Megafunctions

This table lists the signal interface between the output ports of the Altera_PLL megafunction and the input ports of the ALTLVDS transmitter and receiver. As an example, the table lists the serial clock output, load enable output, and parallel clock output generated on ports outclk0, outclk1, and outclk2, along with the locked signal of the Altera_PLL instance. You can choose any of the PLL output clock ports to generate the interface clocks.

From the Altera_PLL Megafunction	To the ALTLVDS Transmitter	To the ALTLVDS Receiver
Serial clock output (outclk0) The serial clock output (outclk0) can only drive tx_inclock on the ALTLVDS transmitter, and rx_inclock on the ALTLVDS receiver. This clock cannot drive the core logic.	tx_inclock (serial clock input to the transmitter)	rx_inclock (serial clock input)
Load enable output (outclk1)	tx_enable (load enable to the transmitter)	rx_enable (load enable for the deserializer)
Parallel clock output (outclk2)	Parallel clock used inside the transmitter core logic in the FPGA fabric	parallel clock used inside the receiver core logic in the FPGA fabric
~(locked)	—	pll_areset (asynchronous PLL reset port) The pll_areset signal is automatically enabled for the LVDS receiver in external PLL mode. This signal does not exist for LVDS transmitter instantiation when the external PLL option is enabled.

Note: With soft SERDES, a different clocking requirement is needed.

Related Information**[LVDS SERDES Transmitter/Receiver \(ALTLVDS_RX/TX\) Megafunction User Guide](#)**

More information about the different clocking requirement for soft SERDES.

Altera_PLL Parameter Values for External PLL Mode

The following example shows the clocking requirements to generate output clocks for ALTLVDS_TX and ALTLVDS_RX using the Altera_PLL megafunction. The examples set the phase shift with the assumption that the clock and data are edge aligned at the pins of the device.

Note: For other clock and data phase relationships, Altera recommends that you first instantiate your ALTLVDS_RX and ALTLVDS_TX interface without using the external PLL mode option. Compile the megafunctions in the Quartus II software and take note of the frequency, phase shift, and duty cycle settings for each clock output. Enter these settings in the Altera_PLL megafunction parameter editor and then connect the appropriate output to the ALTLVDS_RX and ALTLVDS_TX megafunctions.

Table 5-13: Example: Generating Output Clocks Using an Altera_PLL Megafunction

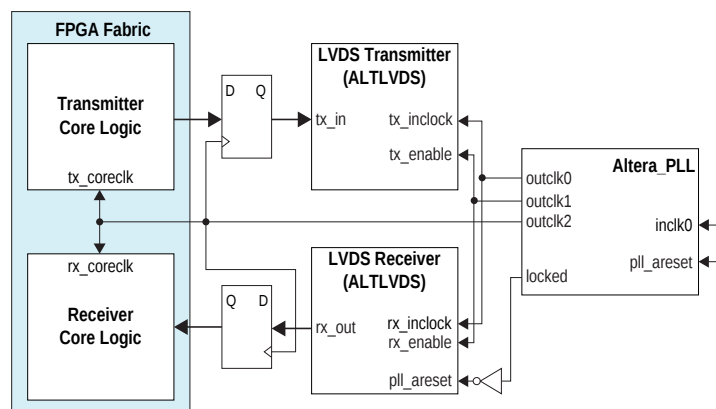
This table lists the parameter values that you can set in the Altera_PLL parameter editor to generate three output clocks using an Altera_PLL megafunction if you are not using DPA and soft-CDR mode.

Parameter	outclk0 (Connects to the tx_inclock port of ALTLVDS_TX and the rx_inclock port of ALTLVDS_RX)	outclk1 (Connects to the tx_enable port of ALTLVDS_TX and the rx_enable port of ALTLVDS_RX)	outclk2 (Used as the core clock for the parallel data registers for both transmitter and receiver)
Frequency	data rate	data rate/serialization factor	data rate/serialization factor
Phase shift	-180°	$[(\text{deserialization factor} - 2) / \text{deserialization factor}] \times 360^\circ$	-180/serialization factor (outclk0 phase shift divided by the serialization factor)
Duty cycle	50%	100/serialization factor	50%

Connection between Altera_PLL and ALTLVDS

Figure 5-4: LVDS Interface with the Altera_PLL Megafunction

This figure shows the connections between the Altera_PLL and ALTLVDS megafunction.



When generating the Altera_PLL megafunction, the **Left/Right PLL** option is configured to set up the PLL in LVDS mode. Instantiation of `pll_aset` is optional.

Guideline: Use the Same V_{CCPD} for All I/O Banks in a Group

In the Cyclone V GX and GT devices, all I/O banks have individual V_{CCPD} pin except the following I/O bank groups, which share one V_{CCPD} pin in each group:

- Bank 3B and 4A
- Bank 7A and 8A

Examples:

- If bank 3B uses a 3.0 V V_{CCPD} , bank 4A must also use 3.0 V V_{CCPD} .
- If bank 8A uses a 2.5 V V_{CCPD} , bank 7A must also use 2.5 V V_{CCPD} .

For more information about the I/O banks available in each device package, refer to the related links.

Related Information

- [Modular I/O Banks for Cyclone V E Devices](#) on page 5-21
- [Modular I/O Banks for Cyclone V GX Devices](#) on page 5-22
- [Modular I/O Banks for Cyclone V GT Devices](#) on page 5-23
- [Modular I/O Banks for Cyclone V SE Devices](#) on page 5-24
- [Modular I/O Banks for Cyclone V SX Devices](#) on page 5-25
- [Modular I/O Banks for Cyclone V ST Devices](#) on page 5-26

Guideline: Ensure Compatible V_{CCIO} and V_{CCPD} Voltage in the Same Bank

When planning I/O bank usage for Cyclone V devices, you must ensure the V_{CCIO} voltage is compatible with the V_{CCPD} voltage of the same bank. Some banks may share the same V_{CCPD} power pin. This limits the possible V_{CCIO} voltages that can be used on banks that share V_{CCPD} power pins.

Examples:

- V_{CCPD3B} is connected to 2.5 V— V_{CCIO} pins for banks 3B and 4A can be connected 1.2 V, 1.25 V, 1.35 V, 1.5 V, 1.8 V, or 2.5 V.
- V_{CCPD3B} is connected to 3.0 V— V_{CCIO} pins for banks 3B and 4A must be connected to 3.0 V.

Guideline: V_{REF} Pin Restrictions

For the Cyclone V devices, consider the following V_{REF} pins guidelines:

- You cannot assign shared V_{REF} pins as LVDS or external memory interface pins.
- SSTL, HSTL, and HSUL I/O standards do not support shared V_{REF} pins. For example, if a particular B1p or B1n pin is a shared V_{REF} pin, the corresponding B1p/B1n pin pair do not have LVDS transmitter support.
- You must perform signal integrity analysis using your board design when using a shared V_{REF} pin to determine the F_{MAX} for your system.

For more information about pin capacitance of the V_{REF} pins, refer to the device datasheet.

Related Information

[Cyclone V Device Datasheet](#)

Guideline: Observe Device Absolute Maximum Rating for 3.3 V Interfacing

To ensure device reliability and proper operation when you use the device for 3.3 V I/O interfacing, do not violate the absolute maximum ratings of the device. For more information about absolute maximum rating and maximum allowed overshoot during transitions, refer to the device datasheet.

Tip: Perform IBIS or SPICE simulations to make sure the overshoot and undershoot voltages are within the specifications.

Transmitter Application

If you use the Cyclone V device as a transmitter, use slow slew-rate and series termination to limit the overshoot and undershoot at the I/O pins. Transmission line effects that cause large voltage deviations at the receiver are associated with an impedance mismatch between the driver and the transmission lines. By matching the impedance of the driver to the characteristic impedance of the transmission line, you can significantly reduce overshoot voltage. You can use a series termination resistor placed physically close to the driver to match the total driver impedance to the transmission line impedance.

Receiver Application

If you use the Cyclone V device as a receiver, use the on-chip clamping diode to limit the overshoot and undershoot voltage at the I/O pins.

Related Information

[Cyclone V Device Datasheet](#)

Guideline: Adhere to the LVDS I/O Restrictions and Differential Pad Placement Rules

For Cyclone V LVDS applications, adhere to these guidelines to avoid adverse impact on LVDS performance:

- I/O restrictions guideline—to avoid excessive jitter on the LVDS transmitter output pins.
- Differential pad placement rule for each device—to avoid crosstalk effects.

Related Information

- [Cyclone V Device Family Pin Connection Guidelines](#)
Describes the I/O restriction guidelines for the Cyclone V LVDS transmitters.
- [Cyclone V Differential Pad Placement Rule and Pad Mapping Files](#)
Provides the pad mapping spreadsheets for Cyclone V devices.

I/O Banks Locations in Cyclone V Devices

The number of Cyclone V I/O banks in a particular device depends on the device density. Each I/O bank can simultaneously support multiple I/O standards.

Note: The availability of I/O banks in device packages varies. For more details, refer to the related links.

Figure 5-5: I/O Banks for Cyclone V E Devices

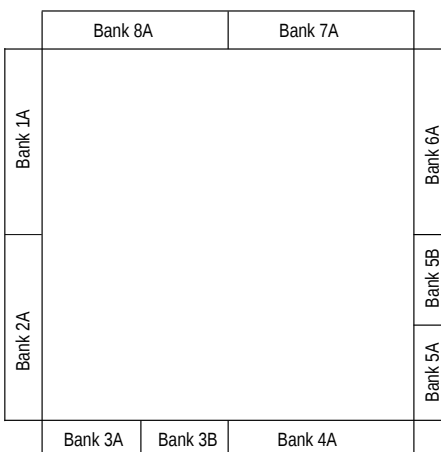


Figure 5-6: I/O Banks for Cyclone V GX and GT Devices

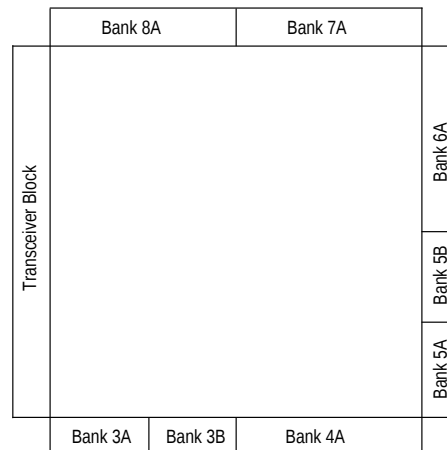


Figure 5-7: I/O Banks for Cyclone V SE Devices

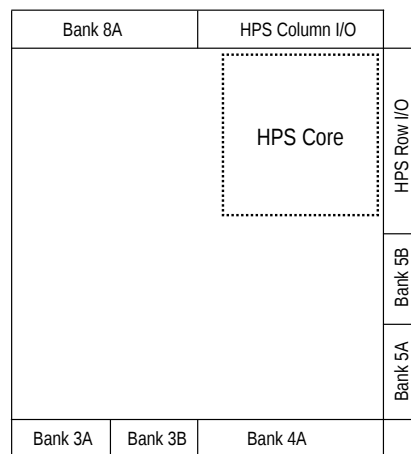
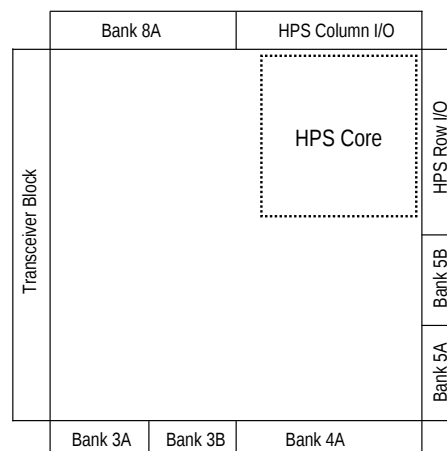


Figure 5-8: I/O Banks for Cyclone V SX and ST Devices



Related Information

- [Modular I/O Banks for Cyclone V E Devices](#) on page 5-21
- [Modular I/O Banks for Cyclone V GX Devices](#) on page 5-22
- [Modular I/O Banks for Cyclone V GT Devices](#) on page 5-23
- [Modular I/O Banks for Cyclone V SE Devices](#) on page 5-24
- [Modular I/O Banks for Cyclone V SX Devices](#) on page 5-25
- [Modular I/O Banks for Cyclone V ST Devices](#) on page 5-26

I/O Banks Groups in Cyclone V Devices

The I/O pins in Cyclone V devices are arranged in groups called modular I/O banks.

Modular I/O Banks for Cyclone V E Devices

Table 5-14: Modular I/O Banks for Cyclone V E A2 and A4 Devices—Preliminary

Member Code		A2					A4				
Package		M383	U324	F256	U484	F484	M383	U324	F256	U484	F484
I/O Bank	1A	16	—	—	—	—	16	—	—	—	—
	2A	32	32	16	16	16	32	32	16	16	16
	3A	16	16	16	16	16	16	16	16	16	16
	3B	21	16	16	32	32	21	16	16	32	32
	4A	38	32	16	48	48	38	32	16	48	48
	5A	16	16	16	16	16	16	16	16	16	16
	5B	16	16	16	16	16	16	16	16	16	16
	7A	38	32	16	48	48	38	32	16	48	48
	8A	30	16	16	32	32	30	16	16	32	32
Total		223	176	128	224	224	223	176	128	224	224

Table 5-15: Modular I/O Banks for Cyclone V E A5, A7, and A9 Devices—Preliminary

Member Code		A5			A7					A9			
Package		M383	U484	F484	M484	U484	F484	F672	F896	U484	F484	F672	F896
I/O Bank	3A	16	16	16	16	16	16	16	32	16	16	16	32
	3B	21	32	32	32	32	32	32	48	32	32	32	48
	4A	38	48	48	48	48	48	80	80	48	48	80	80
	5A	16	16	16	16	16	16	16	32	16	16	16	32
	5B	14	32	16	16	48	16	64	48	48	16	32	48
	6A	—	—	—	32	—	—	16	80	—	—	48	80
	7A	39	48	80	48	48	80	80	80	48	64	80	80
	8A	31	32	32	32	32	32	32	80	32	32	32	80
Total		175	224	240	240	240	240	336	480	240	224	336	480

Related Information

- [I/O Banks Locations in Cyclone V Devices](#) on page 5-19
- [Guideline: Use the Same V_{CCPD} for All I/O Banks in a Group](#) on page 5-17
Provides guidelines about V_{CCPD} and I/O banks groups.

Modular I/O Banks for Cyclone V GX Devices

Table 5-16: Modular I/O Banks for Cyclone V GX C3, C4, and C5 Devices—Preliminary

Member Code		C3			C4			C5				
Package		U324	U484	F484	U484	F484	F672	M301	M383	U484	F484	F672
I/O Bank	3A	16	16	16	16	16	16	16	16	16	16	16
	3B	16	32	32	32	32	32	18	21	32	32	32
	4A	32	48	48	48	48	80	22	38	48	48	80
	5A	16	16	16	16	16	16	16	16	16	16	16
	5B	16	16	16	32	16	64	14	14	32	16	64
	6A	—	—	—	—	—	16	—	—	—	—	16
	7A	32	48	48	48	80	80	23	39	48	80	80
	8A	16	32	32	32	32	32	20	31	32	32	32
Total		144	208	208	224	240	336	129	175	224	240	336

Table 5-17: Modular I/O Banks for Cyclone V GX C7 and C9 Devices—Preliminary

Member Code		C7					C9				
Package		M484	U484	F484	F672	F896	U484	F484	F672	F896	F1152
I/O Bank	3A	16	16	16	16	32	16	16	16	32	48
	3B	32	32	32	32	48	32	32	32	48	48
	4A	48	48	48	80	80	48	48	80	80	96
	5A	16	16	16	16	32	16	16	16	32	48
	5B	16	48	16	64	48	48	16	32	48	48
	6A	32	—	—	16	80	—	—	48	80	80
	7A	48	48	80	80	80	48	64	80	80	96
	8A	32	32	32	32	80	32	32	32	80	96
Total		240	240	240	336	480	240	224	336	480	560

Related Information

- [I/O Banks Locations in Cyclone V Devices](#) on page 5-19
- [Guideline: Use the Same V_{CCPD} for All I/O Banks in a Group](#) on page 5-17
Provides guidelines about V_{CCPD} and I/O banks groups.

Modular I/O Banks for Cyclone V GT Devices

Table 5-18: Modular I/O Banks for Cyclone V GT D5 and D7 Devices—Preliminary

Member Code		D5					D7				
Package		M301	M383	U484	F484	F672	M484	U484	F484	F672	F896
I/O Bank	3A	16	16	16	16	16	16	16	16	16	32
	3B	18	21	32	32	32	32	32	32	32	48
	4A	22	38	48	48	80	48	48	48	80	80
	5A	16	16	16	16	16	16	16	16	16	32
	5B	14	14	32	16	64	16	48	16	64	48
	6A	—	—	—	—	16	32	—	—	16	80
	7A	23	39	48	80	80	48	48	80	80	80
	8A	20	31	32	32	32	32	32	32	32	80
Total		129	175	224	240	336	240	240	240	336	480

Table 5-19: Modular I/O Banks for Cyclone V GT D9 Devices—Preliminary

Member Code		D9				
Package		U484	F484	F672	F896	F1152
I/O Bank	3A	16	16	16	32	48
	3B	32	32	32	48	48
	4A	48	48	80	80	96
	5A	16	16	16	32	48
	5B	48	16	32	48	48
	6A	—	—	48	80	80
	7A	48	64	80	80	96
	8A	32	32	32	80	96
Total		240	224	336	480	560

Related Information

- [I/O Banks Locations in Cyclone V Devices](#) on page 5-19
- [Guideline: Use the Same V_{CCPD} for All I/O Banks in a Group](#) on page 5-17
Provides guidelines about V_{CCPD} and I/O banks groups.

Modular I/O Banks for Cyclone V SE Devices

Table 5-20: Modular I/O Banks for Cyclone V SE Devices—Preliminary

Note: The HPS row and column I/O counts are the number of HPS-specific I/O pins on the device. Each HPS-specific pin may be mapped to several HPS I/Os.

Member Code		A2		A4		A5			A6		
Package		U484	U672	U484	U672	U484	U672	F896	U484	U672	F896
FPGA I/O Bank	3A	16	16	16	16	16	16	32	16	16	32
	3B	6	32	6	32	6	32	48	6	32	48
	4A	22	68	22	68	22	68	80	22	68	80
	5A	16	16	16	16	16	16	32	16	16	32
	5B	—	—	—	—	—	—	16	—	—	16
HPS Row I/O Bank	6A	52	56	52	56	52	56	56	52	56	56
	6B	23	44	23	44	23	44	44	23	44	44

Member Code		A2		A4		A5			A6		
Package		U484	U672	U484	U672	U484	U672	F896	U484	U672	F896
HPS Column I/O Bank	7A	19	19	19	19	19	19	19	19	19	19
	7B	21	22	21	22	21	22	22	21	22	22
	7C	8	12	8	12	8	12	12	8	12	12
	7D	14	14	14	14	14	14	14	14	14	14
FPGA I/O Bank	8A	6	13	6	13	6	13	80	6	13	80
Total		203	312	203	312	203	312	455	203	312	455

Related Information

- [I/O Banks Locations in Cyclone V Devices](#) on page 5-19
- [Guideline: Use the Same V_{CCPD} for All I/O Banks in a Group](#) on page 5-17
Provides guidelines about V_{CCPD} and I/O banks groups.

Modular I/O Banks for Cyclone V SX Devices

Table 5-21: Modular I/O Banks for Cyclone V SX Devices—Preliminary

Note: The HPS row and column I/O counts are the number of HPS-specific I/O pins on the device. Each HPS-specific pin may be mapped to several HPS I/Os.

Member Code		C2	C4	C5		C6	
Package		U672	U672	U672	F896	U672	F896
FPGA I/O Bank	3A	16	16	16	32	16	32
	3B	32	32	32	48	32	48
	4A	68	68	68	80	68	80
	5A	16	16	16	32	16	32
	5B	—	—	—	16	—	16
HPS Row I/O Bank	6A	56	56	56	56	56	56
	6B	44	44	44	44	44	44
HPS Column I/O Bank	7A	19	19	19	19	19	19
	7B	22	22	22	22	22	22
	7C	12	12	12	12	12	12
	7D	14	14	14	14	14	14
FPGA I/O Bank	8A	13	13	13	80	13	80
Total		312	312	312	455	312	455

Related Information

- [I/O Banks Locations in Cyclone V Devices](#) on page 5-19
- [Guideline: Use the Same \$V_{CCPD}\$ for All I/O Banks in a Group](#) on page 5-17
Provides guidelines about V_{CCPD} and I/O banks groups.

Modular I/O Banks for Cyclone V ST Devices

Table 5-22: Modular I/O Banks for Cyclone V ST Devices—Preliminary

Note: The HPS row and column I/O counts are the number of HPS-specific I/O pins on the device. Each HPS-specific pin may be mapped to several HPS I/Os.

Member Code		D5	D6
Package		F896	F896
FPGA I/O Bank	3A	32	32
	3B	48	48
	4A	80	80
	5A	32	32
	5B	16	16
HPS Row I/O Bank	6A	56	56
	6B	44	44
HPS Column I/O Bank	7A	19	19
	7B	22	22
	7C	12	12
	7D	14	14
FPGA I/O Bank	8A	80	80
Total		455	455

Related Information

- [I/O Banks Locations in Cyclone V Devices](#) on page 5-19
- [Guideline: Use the Same \$V_{CCPD}\$ for All I/O Banks in a Group](#) on page 5-17
Provides guidelines about V_{CCPD} and I/O banks groups.

I/O Element Structure in Cyclone V Devices

The I/O elements (IOEs) in Cyclone V devices contain a bidirectional I/O buffer and I/O registers to support a complete embedded bidirectional single data rate (SDR) or double data rate (DDR) transfer.

The IOEs are located in I/O blocks around the periphery of the Cyclone V device.

The Cyclone V SE, SX, and ST devices also have I/O elements for the HPS.

I/O Buffer and Registers in Cyclone V Devices

I/O registers are composed of the input path for handling data from the pin to the core, the output path for handling data from the core to the pin, and the output enable (OE) path for handling the OE signal to the output buffer. These registers allow faster source-synchronous register-to-register transfers and resynchronization.

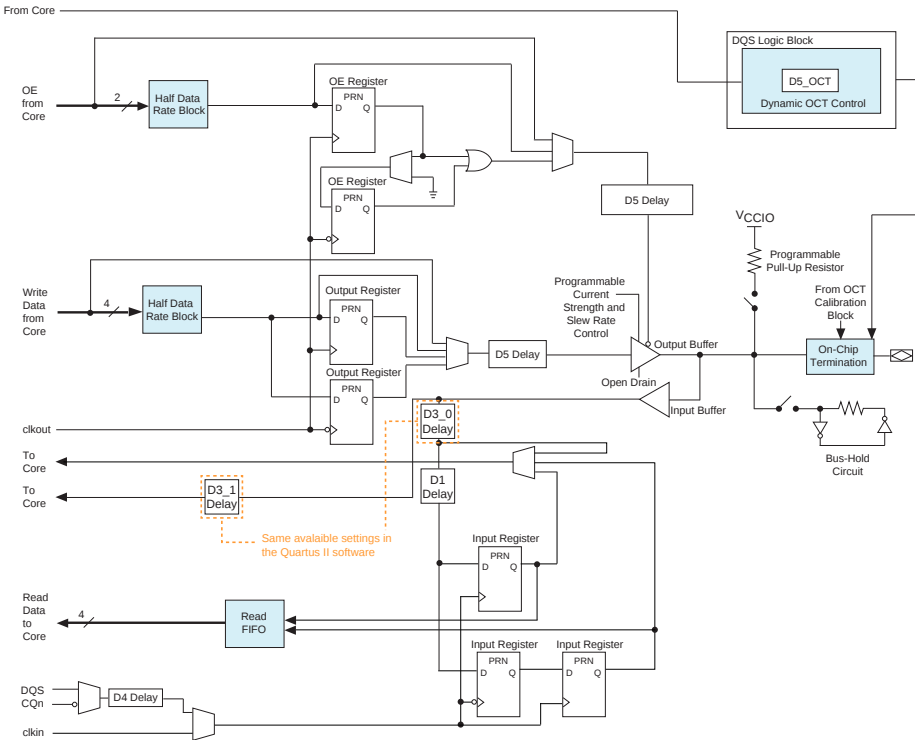
Table 5-23: Input and Output Paths in Cyclone V Devices

This table summarizes the input and output path in the Cyclone V devices.

Input Path	Output Path
Consists of: <ul style="list-style-type: none">• DDR input registers• Alignment and synchronization registers• Half data rate blocks	Consists of: <ul style="list-style-type: none">• Output or OE registers• Alignment registers• Half data rate blocks
You can bypass each block in the input path. The input path uses the deskew delay to adjust the input register clock delay across process, voltage, and temperature (PVT) variations.	You can bypass each block of the output and OE paths.

Figure 5-9: IOE Structure for Cyclone V Devices

This figure shows the Cyclone V FPGA IOE structure. In the figure, one dynamic on-chip termination (OCT) control is available for each DQ/DQS group.



Programmable IOE Features in Cyclone V Devices

Table 5-24: Summary of Supported Cyclone V Programmable IOE Features and Settings

Feature	Setting (Default setting in bold)	Condition	Supported in HPS I/O (SoC FPGA Devices Only)
Slew Rate Control	0 (Slow), 1 (Fast)	Disabled if you use the R _S OCT feature.	Yes
I/O Delay	Refer to the device datasheet	—	—
Open-Drain Output	On, Off	—	Yes
Bus-Hold	On, Off	Disabled if you use the weak pull-up resistor feature.	Yes
Weak Pull-up Resistor	On, Off	Disabled if you use the bus-hold feature.	Yes
Pre-Emphasis	0 (enabled) and 1 (disabled)	For LVDS I/O standard only. Not supported for differential HSTL and SSTL I/O standards.	—
Differential Output Voltage	00 (low), 01 (medium), 10 (high)	—	—
On-Chip Clamp Diode	On, Off	Recommended to turn on for 3.3 V I/O standards	Yes

Note: The on-chip clamp diode is available on all general purpose I/O (GPIO) pins in all Cyclone V device variants.

Related Information

- [Cyclone V Device Datasheet](#)
- [Programmable Current Strength](#) on page 5-29
- [Programmable Output Slew-Rate Control](#) on page 5-30
- [Programmable IOE Delay](#) on page 5-30
- [Programmable Output Buffer Delay](#) on page 5-30
- [Programmable Pre-Emphasis](#) on page 5-31
- [Programmable Differential Output Voltage](#) on page 5-31

Programmable Current Strength

You can use the programmable current strength to mitigate the effects of high signal attenuation that is caused by a long transmission line or a legacy backplane.

Table 5-25: Programmable Current Strength Settings for Cyclone V Devices

The output buffer for each Cyclone V device I/O pin has a programmable current strength control for the I/O standards listed in this table.

I/O Standard	I_{OH} / I_{OL} Current Strength Setting (mA) (Default setting in bold)	Supported in HPS (SoC FPGA Devices Only)
3.3 V LVTTTL	16 , 8, 4	Yes (except 16 mA)
3.3 V LVCMOS	2	Yes
3.0 V LVTTTL	16, 12 , 8, 4	Yes
3.0 V LVCMOS	16, 12 , 8, 4	Yes
2.5 V LVCMOS	16, 12 , 8, 4	Yes
1.8 V LVCMOS	12 , 10, 8, 6, 4, 2	Yes
1.5 V LVCMOS	12 , 10, 8, 6, 4, 2	Yes
1.2 V LVCMOS	8 , 6, 4, 2	—
SSTL-2 Class I	12, 10, 8	—
SSTL-2 Class II	16	—
SSTL-18 Class I	12, 10, 8 , 6, 4	Yes
SSTL-18 Class II	16	Yes
SSTL-15 Class I	12, 10, 8 , 6, 4	Yes
SSTL-15 Class II	16	Yes
1.8 V HSTL Class I	12, 10, 8 , 6, 4	—
1.8 V HSTL Class II	16	—
1.5 V HSTL Class I	12, 10, 8 , 6, 4	Yes
1.5 V HSTL Class II	16	Yes
1.2 V HSTL Class I	12, 10, 8 , 6, 4	—
1.2 V HSTL Class II	16	—

Note: Altera recommends that you perform IBIS or SPICE simulations to determine the best current strength setting for your specific application.

Related Information

[Programmable IOE Features in Cyclone V Devices](#) on page 5-28

Programmable Output Slew-Rate Control

The programmable output slew-rate control in the output buffer of each regular- and dual-function I/O pin allows you to configure the following:

- Fast slew-rate—provides high-speed transitions for high-performance systems.
- Slow slew-rate—reduces system noise and crosstalk but adds a nominal delay to the rising and falling edges.

You can specify the slew-rate on a pin-by-pin basis because each I/O pin contains a slew-rate control.

Note: Altera recommends that you perform IBIS or SPICE simulations to determine the best slew rate setting for your specific application.

Related Information

[Programmable IOE Features in Cyclone V Devices](#) on page 5-28

Programmable IOE Delay

You can activate the programmable IOE delays to ensure zero hold times, minimize setup times, or increase clock-to-output times. This feature helps read and write timing margins because it minimizes the uncertainties between signals in the bus.

Each pin can have a different input delay from pin-to-input register or a delay from output register-to-output pin values to ensure that the signals within a bus have the same delay going into or out of the device.

For more information about the programmable IOE delay specifications, refer to the device datasheet.

Related Information

- [Cyclone V Device Datasheet](#)
- [Programmable IOE Features in Cyclone V Devices](#) on page 5-28

Programmable Output Buffer Delay

The delay chains are built inside the single-ended output buffer. There are four levels of output buffer delay settings. By default, there is no delay.

The delay chains can independently control the rising and falling edge delays of the output buffer, allowing you to:

- Adjust the output-buffer duty cycle
- Compensate channel-to-channel skew
- Reduce simultaneous switching output (SSO) noise by deliberately introducing channel-to-channel skew
- Improve high-speed memory-interface timing margins

For more information about the programmable output buffer delay specifications, refer to the device datasheet.

Related Information

- [Cyclone V Device Datasheet](#)
- [Programmable IOE Features in Cyclone V Devices](#) on page 5-28

Programmable Pre-Emphasis

The V_{OD} setting and the output impedance of the driver set the output current limit of a high-speed transmission signal. At a high frequency, the slew rate may not be fast enough to reach the full V_{OD} level before the next edge, producing pattern-dependent jitter. With pre-emphasis, the output current is boosted momentarily during switching to increase the output slew rate.

Pre-emphasis increases the amplitude of the high-frequency component of the output signal, and thus helps to compensate for the frequency-dependent attenuation along the transmission line. The overshoot introduced by the extra current happens only during a change of state switching to increase the output slew rate and does not ring, unlike the overshoot caused by signal reflection. The amount of pre-emphasis required depends on the attenuation of the high-frequency component along the transmission line.

Figure 5-10: Programmable Pre-Emphasis

This figure shows the LVDS output with pre-emphasis.

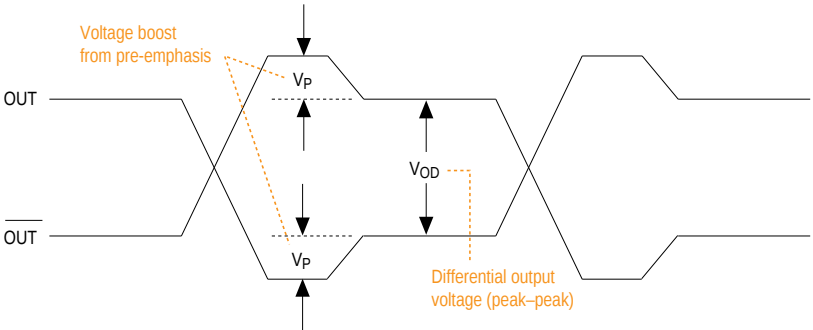


Table 5-26: Quartus II Software Assignment Editor—Programmable Pre-Emphasis

This table lists the assignment name for programmable pre-emphasis and its possible values in the Quartus II software Assignment Editor.

Field	Assignment (Default setting in bold)
To	tx_out
Assignment name	Programmable Pre-emphasis
Allowed values	0 (enabled) and 1 (disabled)

Related Information

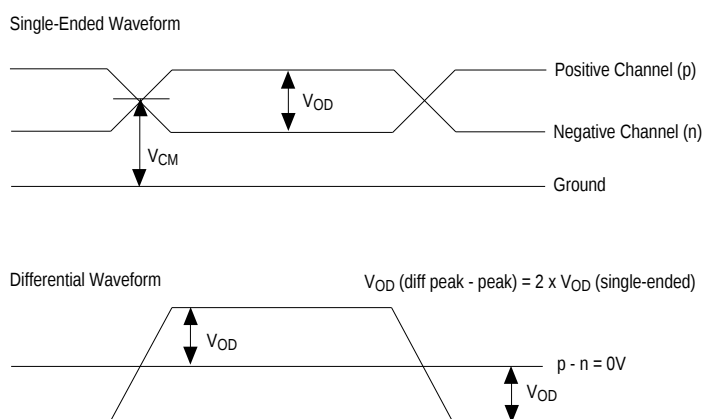
[Programmable IOE Features in Cyclone V Devices](#) on page 5-28

Programmable Differential Output Voltage

The programmable V_{OD} settings allow you to adjust the output eye opening to optimize the trace length and power consumption. A higher V_{OD} swing improves voltage margins at the receiver end, and a smaller V_{OD} swing reduces power consumption. You can statically adjust the V_{OD} of the differential signal by changing the V_{OD} settings in the Quartus II software Assignment Editor.

Figure 5-11: Differential V_{OD}

This figure shows the V_{OD} of the differential LVDS output.

**Table 5-27: Quartus II Software Assignment Editor—Programmable V_{OD}**

This table lists the assignment name for programmable V_{OD} and its possible values in the Quartus II software Assignment Editor. Value "0" is available for the RSDS and mini-LVDS I/O standards only, and is not available for the LVDS I/O standard.

Field	Assignment (Default setting in bold)
To	tx_out
Assignment name	Programmable Differential Output Voltage (V_{OD})
Allowed values	00 (low), 01 (medium), 10 (high)

Related Information

[Programmable IOE Features in Cyclone V Devices](#) on page 5-28

I/O Pins Features for Cyclone V Devices

[Open-Drain Output](#) on page 5-32

[Bus-Hold Circuitry](#) on page 5-33

[Pull-up Resistor](#) on page 5-33

Open-Drain Output

The optional open-drain output for each I/O pin is equivalent to an open collector output. If it is configured as an open drain, the logic value of the output is either high-Z or logic low.

Use an external resistor to pull the signal to a logic high.

Bus-Hold Circuitry

Each I/O pin provides an optional bus-hold feature that is active only after configuration. When the device enters user mode, the bus-hold circuit captures the value that is present on the pin by the end of the configuration.

The bus-hold circuitry uses a resistor with a nominal resistance (R_{BH}), approximately 7 k Ω , to weakly pull the signal level to the last-driven state of the pin. The bus-hold circuitry holds this pin state until the next input signal is present. Because of this, you do not require an external pull-up or pull-down resistor to hold a signal level when the bus is tri-stated.

For each I/O pin, you can individually specify that the bus-hold circuitry pulls non-driven pins away from the input threshold voltage—where noise can cause unintended high-frequency switching. To prevent over-driving signals, the bus-hold circuitry drives the voltage level of the I/O pin lower than the V_{CCIO} level.

If you enable the bus-hold feature, you cannot use the programmable pull-up option. To configure the I/O pin for differential signals, disable the bus-hold feature.

Pull-up Resistor

Each I/O pin provides an optional programmable pull-up resistor during user mode. The pull-up resistor weakly holds the I/O to the V_{CCIO} level.

The Cyclone V device supports programmable weak pull-up resistors only on user I/O pins but not on dedicated configuration pins, dedicated clock pins, or JTAG pins.

If you enable this option, you cannot use the bus-hold feature.

On-Chip I/O Termination in Cyclone V Devices

Dynamic R_S and R_T OCT provides I/O impedance matching and termination capabilities. OCT maintains signal quality, saves board space, and reduces external component costs.

The Cyclone V devices support OCT in all FPGA I/O banks. For the HPS I/Os, the column I/Os do not support OCT.

Table 5-28: OCT Schemes Supported in Cyclone V Devices

Direction	OCT Schemes	Supported in HPS Row I/Os
Output	R_S OCT with calibration	Yes
	R_S OCT without calibration	Yes
Input	R_T OCT with calibration	Yes
	R_D OCT (LVDS and SLVS I/O standards only)	—
Bidirectional	Dynamic R_S OCT and R_T OCT	Yes

Related Information

- [R_S OCT without Calibration in Cyclone V Devices](#) on page 5-34

- [R_S OCT with Calibration in Cyclone V Devices](#) on page 5-35
- [R_T OCT with Calibration in Cyclone V Devices](#) on page 5-37
- [LVDS Input R_D OCT in Cyclone V Devices](#) on page 5-40
- [Dynamic OCT in Cyclone V Devices](#) on page 5-39

R_S OCT without Calibration in Cyclone V Devices

The Cyclone V devices support R_S OCT for single-ended and voltage-referenced I/O standards. R_S OCT without calibration is supported on output only.

Table 5-29: Selectable I/O Standards for R_S OCT Without Calibration

This table lists the output termination settings for uncalibrated OCT on different I/O standards.

I/O Standard	Uncalibrated OCT (Output)
	R _S (Ω)
3.0 V LVTTTL/3.0 V LVCMOS	25/50
2.5 V LVCMOS	25/50
1.8 V LVCMOS	25/50
1.5 V LVCMOS	25/50
1.2 V LVCMOS	25/50
SSTL-2 Class I	50
SSTL-2 Class II	25
SSTL-18 Class I	50
SSTL-18 Class II	25
SSTL-15 Class I	50
SSTL-15 Class II	25
1.8 V HSTL Class I	50
1.8 V HSTL Class II	25
1.5 V HSTL Class I	50
1.5 V HSTL Class II	25
1.2 V HSTL Class I	50
1.2 V HSTL Class II	25
Differential SSTL-2 Class I	50
Differential SSTL-2 Class II	25
Differential SSTL-18 Class I	50
Differential SSTL-18 Class II	25
Differential SSTL-15 Class I	50

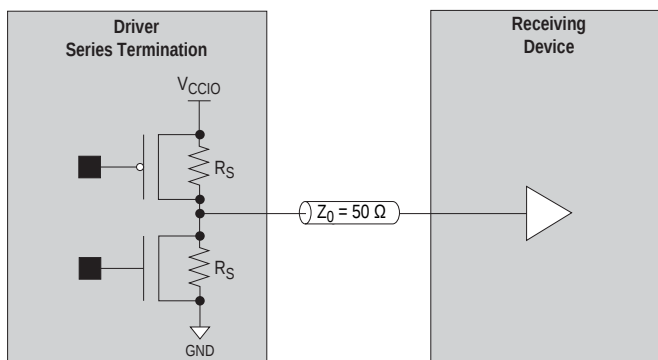
I/O Standard	Uncalibrated OCT (Output)
	R _S (Ω)
Differential SSTL-15 Class II	25
Differential 1.8 V HSTL Class I	50
Differential 1.8 V HSTL Class II	25
Differential 1.5 V HSTL Class I	50
Differential 1.5 V HSTL Class II	25
Differential 1.2 V HSTL Class I	50
Differential 1.2 V HSTL Class II	25

Driver-impedance matching provides the I/O driver with controlled output impedance that closely matches the impedance of the transmission line. As a result, you can significantly reduce signal reflections on PCB traces.

If you select matching impedance, current strength is no longer selectable.

Figure 5-12: R_S OCT Without Calibration

This figure shows the R_S as the intrinsic impedance of the output transistors.



Related Information

[On-Chip I/O Termination in Cyclone V Devices](#) on page 5-33

R_S OCT with Calibration in Cyclone V Devices

The Cyclone V devices support R_S OCT with calibration in all banks.

Table 5-30: Selectable I/O Standards for R_S OCT With Calibration

This table lists the output termination settings for calibrated OCT on different I/O standards.

I/O Standard	Calibrated OCT (Output)	
	R _S (Ω) ⁽¹¹⁾	RZQ (Ω)
3.0 V LVTTTL/3.0 V LVCMOS	25/50	100

⁽¹¹⁾ Final values are pending silicon characterization.

I/O Standard	Calibrated OCT (Output)	
	R _S (Ω) ⁽¹¹⁾	RZQ (Ω)
2.5 V LVCMOS	25/50	100
1.8 V LVCMOS	25/50	100
1.5 V LVCMOS	25/50	100
1.2 V LVCMOS	25/50	100
SSTL-2 Class I	50	100
SSTL-2 Class II	25	100
SSTL-18 Class I	50	100
SSTL-18 Class II	25	100
SSTL-15 Class I	50	100
SSTL-15 Class II	25	100
1.8 V HSTL Class I	50	100
1.8 V HSTL Class II	25	100
1.5 V HSTL Class I	50	100
1.5 V HSTL Class II	25	100
1.2 V HSTL Class I	50	100
1.2 V HSTL Class II	25	100
Differential SSTL-2 Class I	50	100
Differential SSTL-2 Class II	25	100
Differential SSTL-18 Class I	50	100
Differential SSTL-18 Class II	25	100
Differential SSTL-15 Class I	50	100
Differential SSTL-15 Class II	25	100
Differential 1.8 V HSTL Class I	50	100
Differential 1.8 V HSTL Class II	25	100
Differential 1.5 V HSTL Class I	50	100
Differential 1.5 V HSTL Class II	25	100
Differential 1.2 V HSTL Class I	50	100
Differential 1.2 V HSTL Class II	25	100
SSTL-15	25, 50	100
	34, 40	240
SSTL-135	34, 40	240

⁽¹¹⁾ Final values are pending silicon characterization.

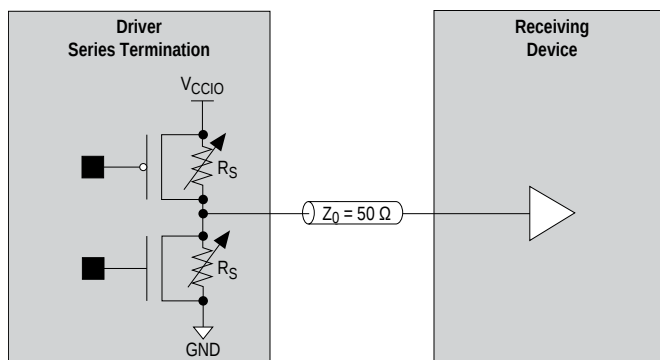
I/O Standard	Calibrated OCT (Output)	
	R _S (Ω) ⁽¹¹⁾	RZQ (Ω)
SSTL-125	34, 40	240
HSUL-12	34, 40, 48, 60, 80	240
Differential SSTL-15	25, 50	100
	34, 40	240
Differential SSTL-135	34, 40	240
Differential SSTL-125	34, 40	240
Differential HSUL-12	34, 40, 48, 60, 80	240

The R_S OCT calibration circuit compares the total impedance of the I/O buffer to the external reference resistor connected to the RZQ pin and dynamically enables or disables the transistors until they match.

Calibration occurs at the end of device configuration. When the calibration circuit finds the correct impedance, the circuit powers down and stops changing the characteristics of the drivers.

Figure 5-13: R_S OCT with Calibration

This figure shows the R_S as the intrinsic impedance of the output transistors.



Related Information

[On-Chip I/O Termination in Cyclone V Devices](#) on page 5-33

R_T OCT with Calibration in Cyclone V Devices

The Cyclone V devices support R_T OCT with calibration in all banks. R_T OCT with calibration is available only for configuration of input and bidirectional pins. Output pin configurations do not support R_T OCT with calibration. If you use R_T OCT, the V_{CCIO} of the bank must match the I/O standard of the pin where you enable the R_T OCT.

⁽¹¹⁾ Final values are pending silicon characterization.

Table 5-31: Selectable I/O Standards for R_T OCT With Calibration

This table lists the input termination settings for calibrated OCT on different I/O standards.

I/O Standard	Calibrated OCT (Input)	
	R _T (Ω) ⁽¹²⁾	RZQ (Ω)
SSTL-2 Class I	50	100
SSTL-2 Class II	50	100
SSTL-18 Class I	50	100
SSTL-18 Class II	50	100
SSTL-15 Class I	50	100
SSTL-15 Class II	50	100
1.8 V HSTL Class I	50	100
1.8 V HSTL Class II	50	100
1.5 V HSTL Class I	50	100
1.5 V HSTL Class II	50	100
1.2 V HSTL Class I	50	100
1.2 V HSTL Class II	50	100
Differential SSTL-2 Class I	50	100
Differential SSTL-2 Class II	50	100
Differential SSTL-18 Class I	50	100
Differential SSTL-18 Class II	50	100
Differential SSTL-15 Class I	50	100
Differential SSTL-15 Class II	50	100
Differential 1.8 V HSTL Class I	50	100
Differential 1.8 V HSTL Class II	50	100
Differential 1.5 V HSTL Class I	50	100
Differential 1.5 V HSTL Class II	50	100
Differential 1.2 V HSTL Class I	50	100
Differential 1.2 V HSTL Class II	50	100
SSTL-15	20, 30, 40, 60,120	240
SSTL-135	20, 30, 40, 60, 120	240
SSTL-125	20, 30, 40, 60, 120	240
Differential SSTL-15	20, 30, 40, 60,120	240
Differential SSTL-135	20, 30, 40, 60, 120	240

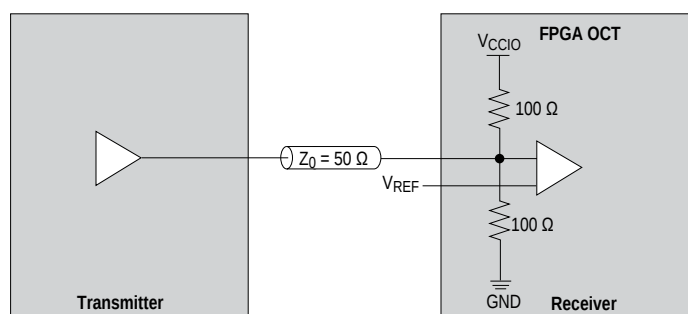
⁽¹²⁾ Final values are pending silicon characterization.

I/O Standard	Calibrated OCT (Input)	
	$R_T (\Omega)^{(12)}$	RZQ (Ω)
Differential SSTL-125	20, 30, 40, 60, 120	240

The R_T OCT calibration circuit compares the total impedance of the I/O buffer to the external resistor connected to the RZQ pin. The circuit dynamically enables or disables the transistors until the total impedance of the I/O buffer matches the external resistor.

Calibration occurs at the end of the device configuration. When the calibration circuit finds the correct impedance, the circuit powers down and stops changing the characteristics of the drivers.

Figure 5-14: R_T OCT with Calibration



Related Information

[On-Chip I/O Termination in Cyclone V Devices](#) on page 5-33

Dynamic OCT in Cyclone V Devices

Dynamic OCT is useful for terminating a high-performance bidirectional path by optimizing the signal integrity depending on the direction of the data. Dynamic OCT also helps save power because device termination is internal—termination switches on only during input operation and thus draw less static power.

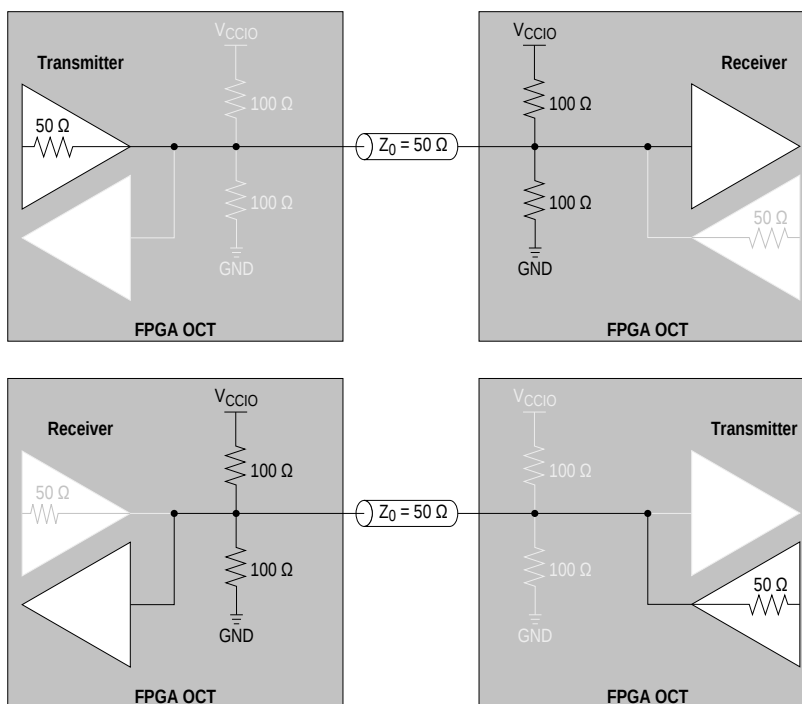
Note: If you use the SSTL-15, SSTL-135, and SSTL-125 I/O standards with the DDR3 memory interface, Altera recommends that you use dynamic OCT with these I/O standards to save board space and cost. Dynamic OCT reduces the number of external termination resistors used.

Table 5-32: Dynamic OCT Based on Bidirectional I/O

Dynamic R_T OCT or R_S OCT is enabled or disabled based on whether the bidirectional I/O acts as a receiver or driver.

Dynamic OCT	Bidirectional I/O	State
Dynamic R_T OCT	Acts as a receiver	Enabled
	Acts as a driver	Disabled
Dynamic R_S OCT	Acts as a receiver	Disabled
	Acts as a driver	Enabled

⁽¹²⁾ Final values are pending silicon characterization.

Figure 5-15: Dynamic R_T OCT in Cyclone V Devices**Related Information**

[On-Chip I/O Termination in Cyclone V Devices](#) on page 5-33

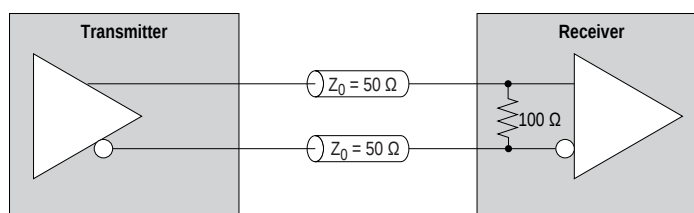
LVDS Input R_D OCT in Cyclone V Devices

The Cyclone V devices support R_D OCT in all I/O banks.

You can use R_D OCT if you set the V_{CCPD} to 2.5 V.

Figure 5-16: Differential Input OCT

The Cyclone V devices support OCT for differential LVDS and SLVS input buffers with a nominal resistance value of 100 Ω , as shown in this figure.

**Related Information**

[On-Chip I/O Termination in Cyclone V Devices](#) on page 5-33

OCT Calibration Block in Cyclone V Devices

You can calibrate the OCT using any of the available four OCT calibration blocks for each device. Each calibration block contains one RZQ pin.

You can use R_S and R_T OCT in the same I/O bank for different I/O standards if the I/O standards use the same V_{CCIO} supply voltage. You cannot configure the R_S OCT and the programmable current strength for the same I/O buffer.

The OCT calibration process uses the RZQ pin that is available in every calibration block in a given I/O bank for series- and parallel-calibrated termination:

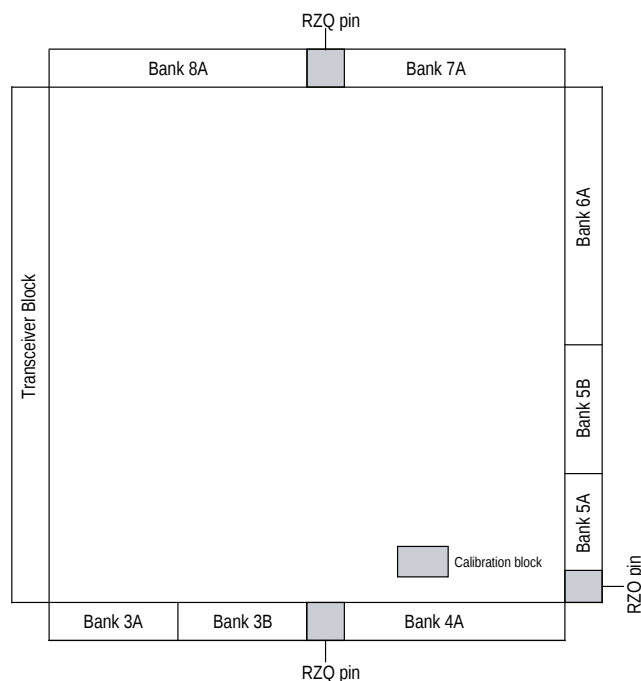
- Connect the RZQ pin to GND through an external 100 Ω or 240 Ω resistor (depending on the R_S or R_T OCT value).
- The RZQ pin shares the same V_{CCIO} supply voltage with the I/O bank where the pin is located.

Cyclone V devices support calibrated R_S and calibrated R_T OCT on all I/O pins except for dedicated configuration pins.

Calibration Block Locations in Cyclone V Devices

Figure 5-17: OCT Calibration Block and RZQ Pin Location—Preliminary

This figure shows the location of I/O banks with OCT calibration blocks and RZQ pins in the Cyclone V device.



Sharing an OCT Calibration Block on Multiple I/O Banks

An OCT calibration block has the same V_{CCIO} as the I/O bank that contains the block. All I/O banks with the same V_{CCIO} can share one OCT calibration block, even if that particular I/O bank has an OCT calibration block.

I/O banks that do not have calibration blocks share the calibration blocks in the I/O banks that have calibration blocks.

All I/O banks support OCT calibration with different V_{CCIO} voltage standards, up to the number of available OCT calibration blocks.

You can configure the I/O banks to receive calibration codes from any OCT calibration block with the same V_{CCIO} . If a group of I/O banks has the same V_{CCIO} voltage, you can use one OCT calibration block to calibrate the group of I/O banks placed around the periphery.

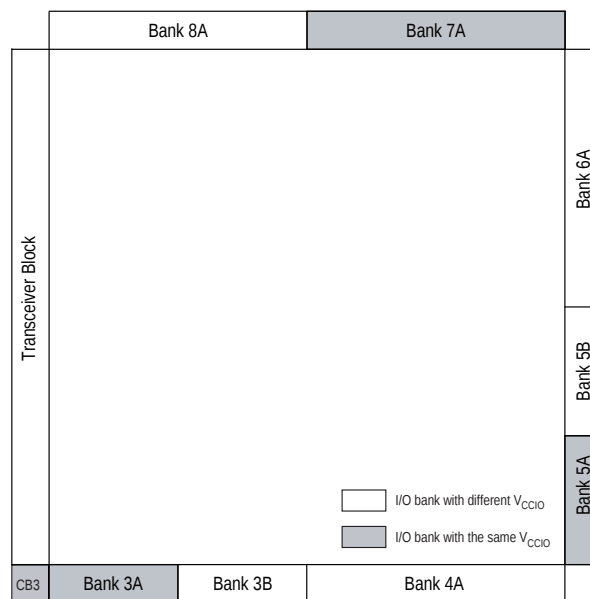
Related Information

- [OCT Calibration Block Sharing Example](#) on page 5-42
- [Dynamic Calibrated On-Chip Termination \(ALTOCT\) Megafunction User Guide](#)
Provides more information about the OCT calibration block.

OCT Calibration Block Sharing Example

Figure 5-18: Example of Calibrating Multiple I/O Banks with One Shared OCT Calibration Block—Preliminary

As an example, this figure shows a group of I/O banks that has the same V_{CCIO} voltage. The figure does not show transceiver calibration blocks.



Because banks 5A and 7A have the same V_{CCIO} as bank 3A, you can calibrate all three I/O banks (3A, 5A, and 7A) with the OCT calibration block (CB3) located in bank 3A.

To enable this calibration, serially shift out the R_S OCT calibration codes from the OCT calibration block in bank 3A to the I/O banks around the periphery.

Related Information

- [Sharing an OCT Calibration Block on Multiple I/O Banks](#) on page 5-41

- [Dynamic Calibrated On-Chip Termination \(ALTOCT\) Megafunction User Guide](#)
Provides more information about the OCT calibration block.

External I/O Termination for Cyclone V Devices

Table 5-33: External Termination Schemes for Different I/O Standards

I/O Standard	External Termination Scheme
3.3 V LVTTTL/3.3 V LVCMOS	No external termination required
3.0 V LVVTTL/3.0 V LVCMOS	
3.0 V PCI	
3.0 V PCI-X	
2.5 V LVCMOS	
1.8 V LVCMOS	
1.5 V LVCMOS	
1.2 V LVCMOS	
SSTL-2 Class I	Single-Ended SSTL I/O Standard Termination
SSTL-2 Class II	
SSTL-18 Class I	
SSTL-18 Class II	
SSTL-15 Class I	
SSTL-15 Class II	
1.8 V HSTL Class I	Single-Ended HSTL I/O Standard Termination
1.8 V HSTL Class II	
1.5 V HSTL Class I	
1.5 V HSTL Class II	
1.2 V HSTL Class I	
1.2 V HSTL Class II	
Differential SSTL-2 Class I	Differential SSTL I/O Standard Termination
Differential SSTL-2 Class II	
Differential SSTL-18 Class I	
Differential SSTL-18 Class II	
Differential SSTL-15 Class I	
Differential SSTL-15 Class II	

I/O Standard	External Termination Scheme
Differential 1.8 V HSTL Class I	Differential HSTL I/O Standard Termination
Differential 1.8 V HSTL Class II	
Differential 1.5 V HSTL Class I	
Differential 1.5 V HSTL Class II	
Differential 1.2 V HSTL Class I	
Differential 1.2 V HSTL Class II	
LVDS	LVDS I/O Standard Termination
RSDS	RSDS/mini-LVDS I/O Standard Termination
Mini-LVDS	
LVPECL	Differential LVPECL I/O Standard Termination
SLVS	SLVS I/O Standard Termination
SSTL-15 ⁽¹³⁾	No external termination required
SSTL-135 ⁽¹³⁾	
SSTL-125 ⁽¹³⁾	
HSUL-12	
Differential SSTL-15 ⁽¹³⁾	
Differential SSTL-135 ⁽¹³⁾	
Differential SSTL-125 ⁽¹³⁾	
Differential HSUL-12	

Single-ended I/O Termination

Voltage-referenced I/O standards require an input V_{REF} and a termination voltage (V_{TT}). The reference voltage of the receiving device tracks the termination voltage of the transmitting device.

The supported I/O standards such as SSTL-125, SSTL-135, and SSTL-15 typically do not require external board termination.

Altera recommends that you use dynamic OCT with these I/O standards to save board space and cost. Dynamic OCT reduces the number of external termination resistors used.

Note: You cannot use R_S and R_T OCT simultaneously. For more information, refer to the related information.

⁽¹³⁾ Altera recommends that you use dynamic OCT with these I/O standards to save board space and cost. Dynamic OCT reduces the number of external termination resistors used.

Figure 5-19: SSTL I/O Standard Termination

This figure shows the details of SSTL I/O termination on Cyclone V devices.

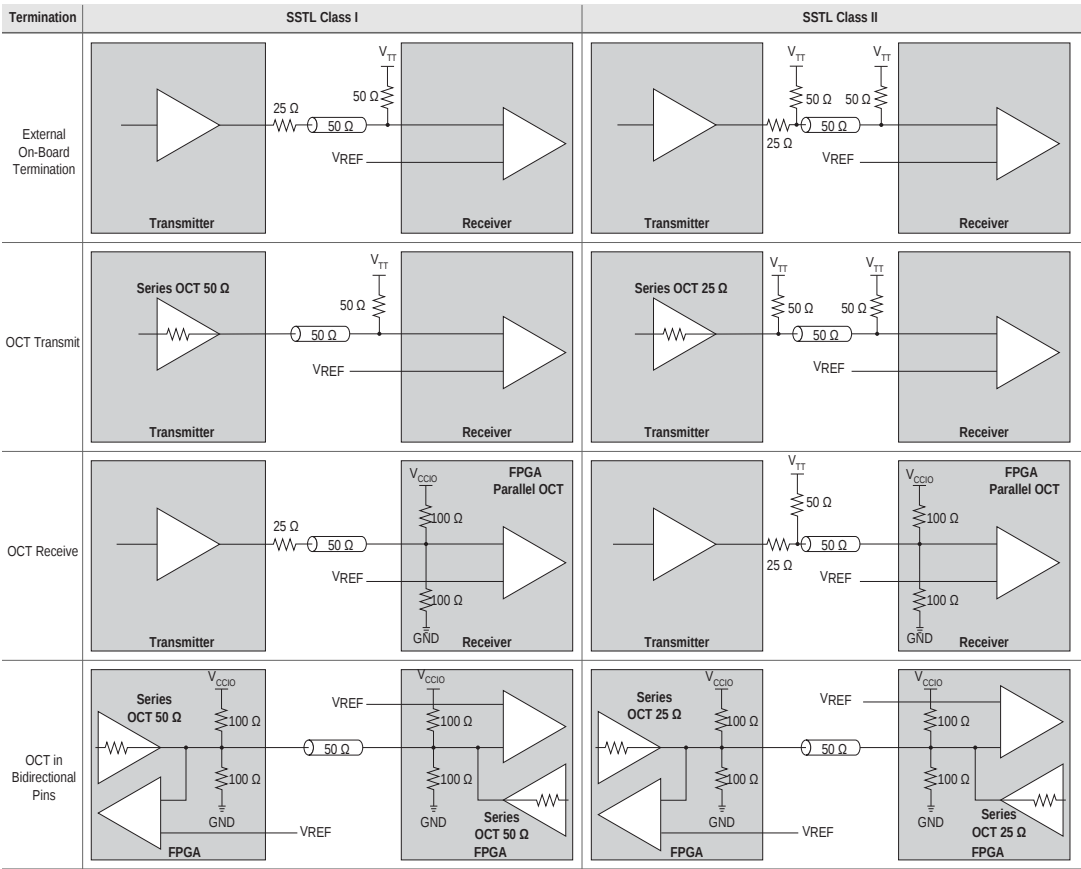
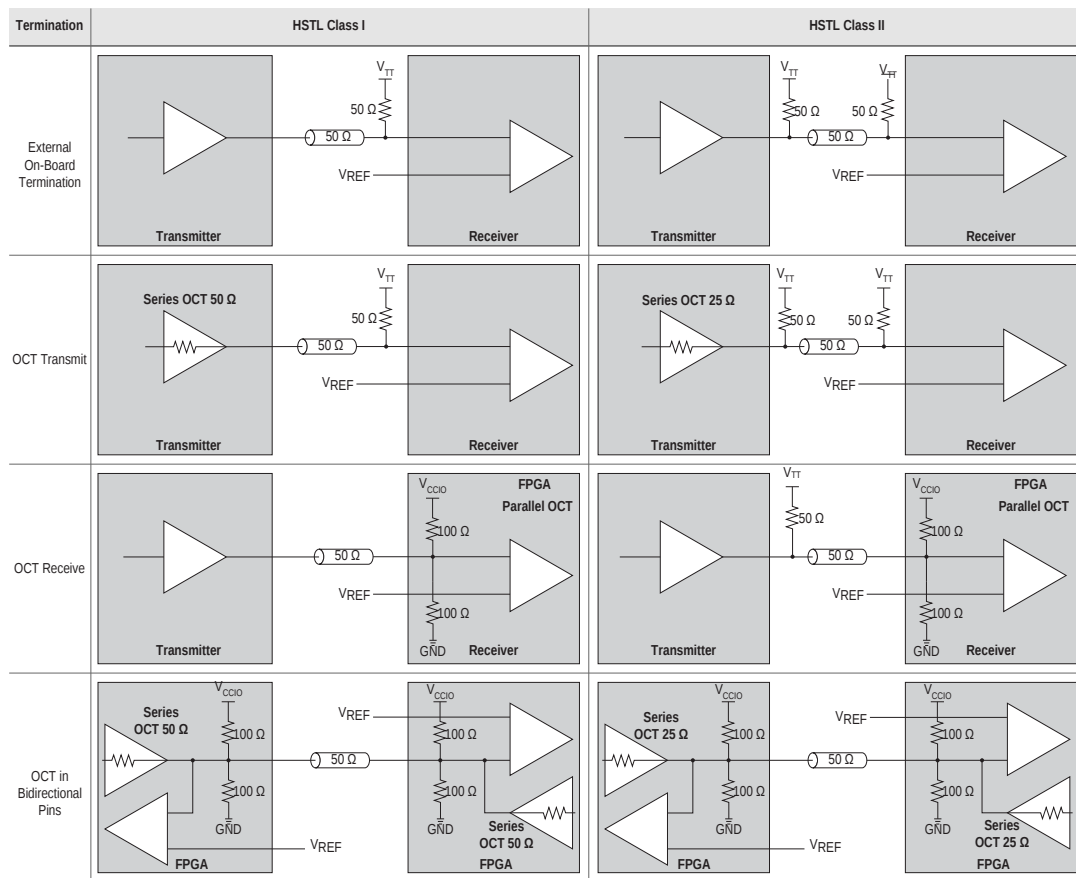


Figure 5-20: HSTL I/O Standard Termination

This figure shows the details of HSTL I/O termination on the Cyclone V devices.



Related Information

[Dynamic OCT in Cyclone V Devices](#) on page 5-39

Differential I/O Termination

The I/O pins are organized in pairs to support differential I/O standards. Each I/O pin pair can support differential input and output buffers.

The supported I/O standards such as Differential SSTL-15, Differential SSTL-125, and Differential SSTL-135 typically do not require external board termination.

Altera recommends that you use dynamic OCT with these I/O standards to save board space and cost. Dynamic OCT reduces the number of external termination resistors used.

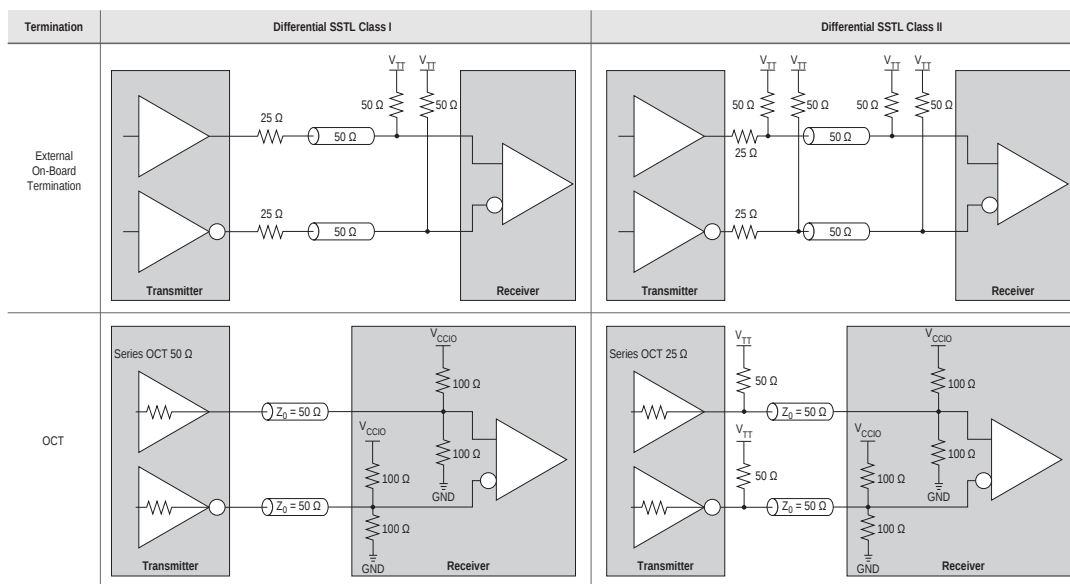
Differential HSTL, SSTL, and HSUL Termination

Differential HSTL, SSTL, and HSUL inputs use LVDS differential input buffers. However, R_D support is only available if the I/O standard is LVDS.

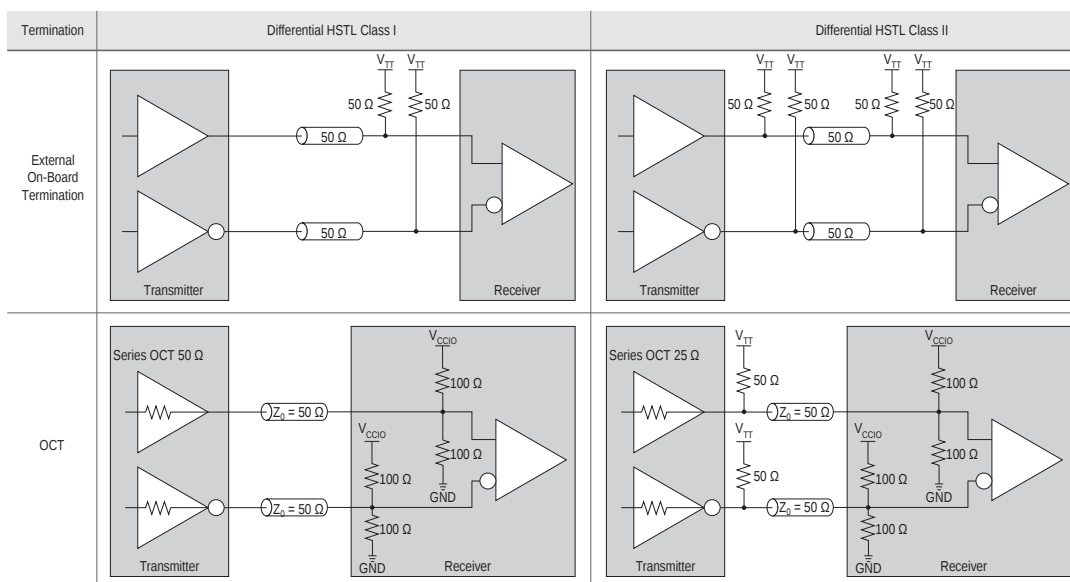
Differential HSTL, SSTL, and HSUL outputs are not true differential outputs. These I/O standards use two single-ended outputs with the second output programmed as inverted.

Figure 5-21: Differential SSTL I/O Standard Termination

This figure shows the details of Differential SSTL I/O termination on Cyclone V devices.

**Figure 5-22: Differential HSTL I/O Standard Termination**

This figure shows the details of Differential HSTL I/O standard termination on Cyclone V devices.

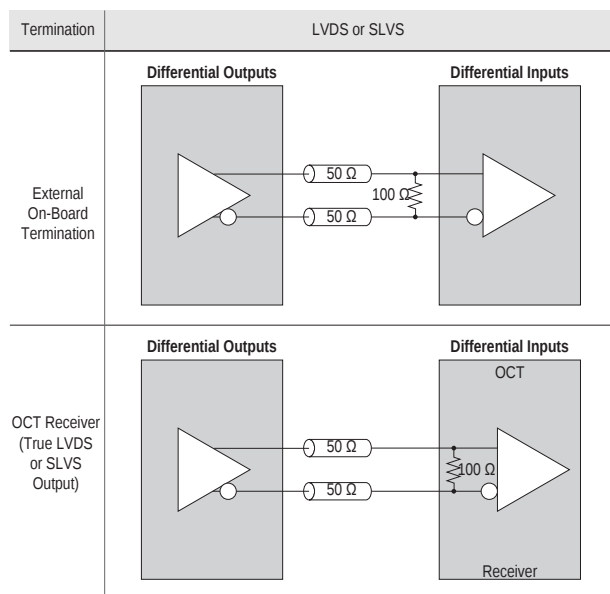


LVDS, RSDS, SLVS, and Mini-LVDS Termination

All I/O banks have dedicated circuitry to support the true LVDS, RSDS, SLVS, and mini-LVDS I/O standards by using true LVDS output buffers without resistor networks.

Figure 5-23: LVDS and SLVS I/O Standard Termination

This figure shows the LVDS and SLVS I/O standards termination. The on-chip differential resistor is available in all I/O banks.



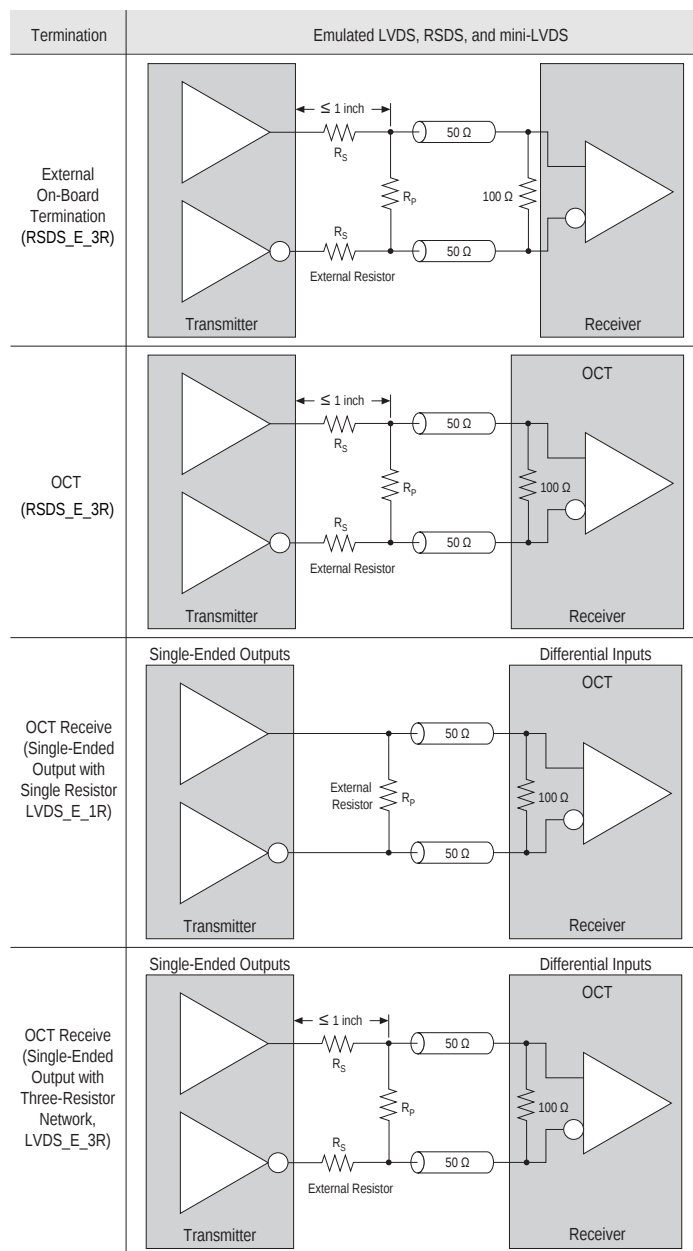
Emulated LVDS, RSDS, and Mini-LVDS Termination

The I/O banks also support emulated LVDS, RSDS, and mini-LVDS I/O standards.

Emulated LVDS, RSDS and mini-LVDS output buffers use two single-ended output buffers with an external single-resistor or three-resistor network, and can be tri-stated.

Figure 5-24: Emulated LVDS, RSDS, or Mini-LVDS I/O Standard Termination

The output buffers, as shown in this figure, are available in all I/O banks. R_S and R_P values are pending characterization.



To meet the RSDS or mini-LVDS specifications, you require a resistor network to attenuate the output-voltage swing.

You can modify the three-resistor network values to reduce power or improve the noise margin. Choose resistor values that satisfy the following equation.

Figure 5-25: Resistor Network Calculation

$$\frac{R_S \times \frac{R_P}{2}}{R_S + \frac{R_P}{2}} = 50 \, \Omega$$

Note: Altera recommends that you perform additional simulations with IBIS or SPICE models to validate that the custom resistor values meet the RSDS or mini-LVDS I/O standard requirements.

For information about the data rates supported for external single resistor or three-resistor network, refer to the device datasheet.

Related Information

- [Cyclone V Device Datasheet](#)

- [National Semiconductor \(www.national.com\)](#)

For more information about the RSDS I/O standard, refer to the *RSDS Specification* on the National Semiconductor web site.

LVPECL Termination

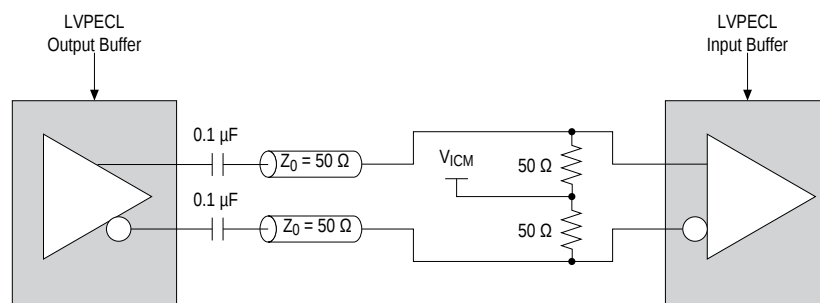
The Cyclone V devices support the LVPECL I/O standard on input clock pins only:

- LVPECL input operation is supported using LVDS input buffers.
- LVPECL output operation is not supported.

Use AC coupling if the LVPECL common-mode voltage of the output buffer does not match the LVPECL input common-mode voltage.

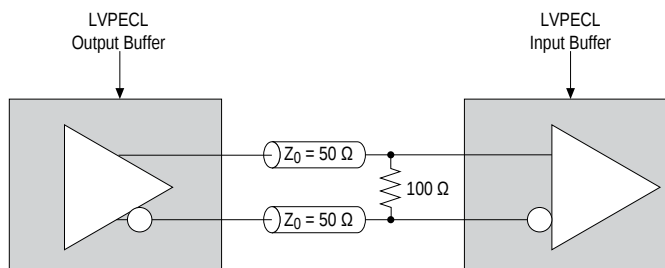
Note: Altera recommends that you use IBIS models to verify your LVPECL AC/DC-coupled termination.

Figure 5-26: LVPECL AC-Coupled Termination



Support for DC-coupled LVPECL is available if the LVPECL output common mode voltage is within the Cyclone V LVPECL input buffer specification.

Figure 5-27: LVPECL DC-Coupled Termination



For information about the V_{ICM} specification, refer to the device datasheet.

Related Information

[Cyclone V Device Datasheet](#)

Dedicated High-Speed Circuitries

The Cyclone V device has dedicated circuitries for differential transmitter and receiver to transmit or receive high-speed differential signals.

Table 5-34: Features and Dedicated Circuitries of the Differential Transmitter and Receiver

Feature	Differential Transmitter	Differential Receiver
True differential buffer	LVDS, mini-LVDS, and RSDS	LVDS, SLVS, mini-LVDS, and RSDS
SERDES	Up to 10 bit serializer	Up to 10 bit deserializer
Fractional PLL	Clocks the load and shift registers	Generates different phases of a clock for data synchronizer
Programmable V_{OD}	Static	—
Programmable pre-emphasis	Boosts output current	—
Data realignment block (Bit-slip)	—	Inserts bit latencies into serial data
Skew adjustment	—	Manual
On-chip termination (OCT)	—	100 Ω in LVDS and SLVS standards

Related Information

Guideline: [Use PLLs in Integer PLL Mode for LVDS](#) on page 5-12

High-Speed Differential I/O Locations

The following figures show the locations of the dedicated serializer/deserializer (SERDES) circuitry and the high-speed I/Os in the Cyclone V devices.

Figure 5-28: High-Speed Differential I/O Locations in Cyclone V E A2 and A4 Devices

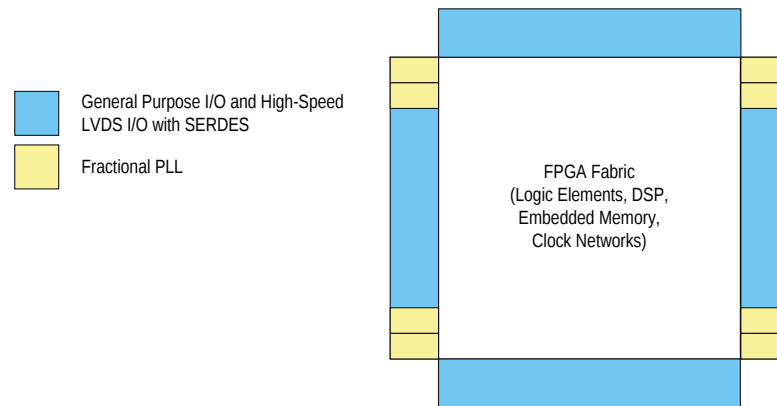


Figure 5-29: High-Speed Differential I/O Locations in Cyclone V GX C3 Devices

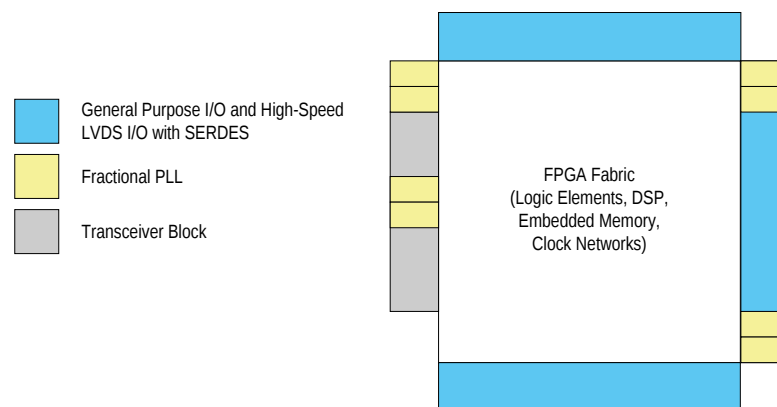


Figure 5-30: High-Speed Differential I/O Locations in Cyclone V GX C4, C5, C7, and C9 Devices, and Cyclone V GT D5, D7, and D9 Devices

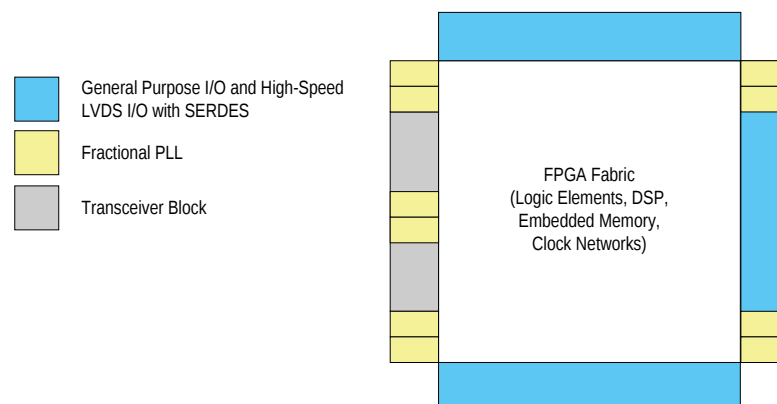
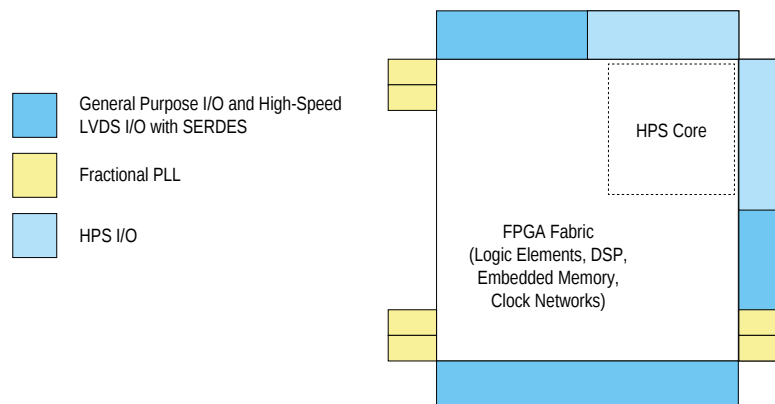
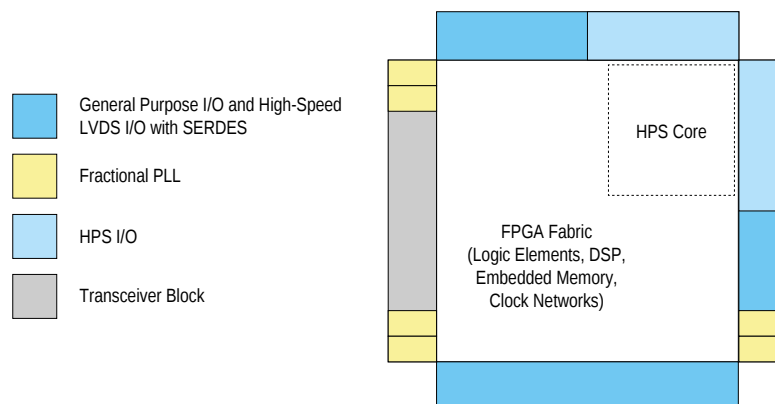


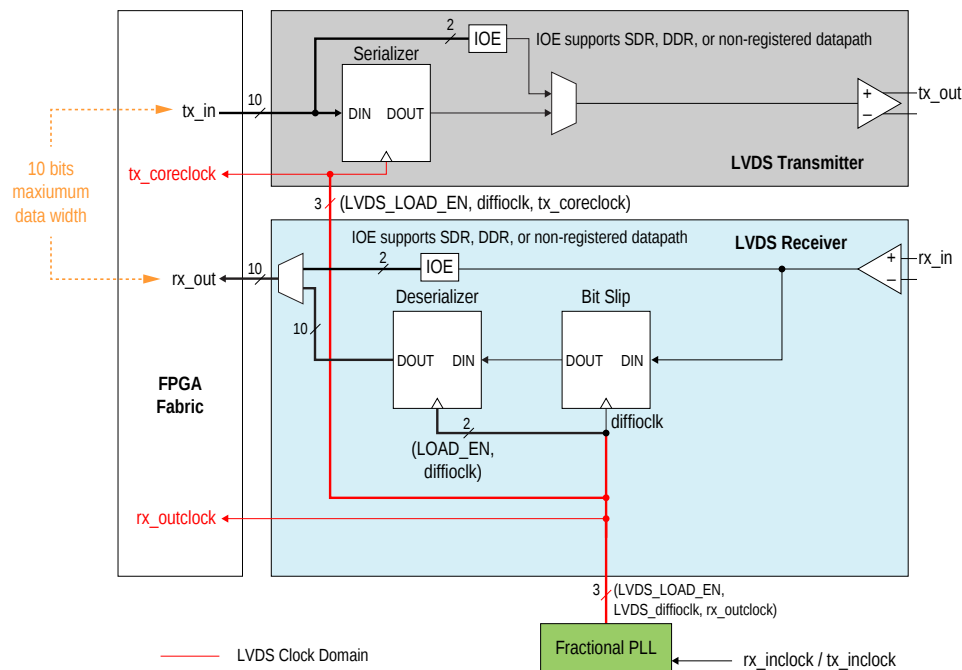
Figure 5-31: High-Speed Differential I/O Locations in Cyclone V SE A2, A4, A5, and A6 Devices**Figure 5-32: High-Speed Differential I/O Locations in Cyclone V SX C2, C4, C5, and C6 Devices, and Cyclone V ST D5 and D6 Devices****Related Information**

- [PLLs and Clocking](#) on page 5-12
I/O design guidelines related to PLLs and clocking.
- [Guideline: Use PLLs in Integer PLL Mode for LVDS](#) on page 5-12

LVDS SERDES Circuitry

The following figure shows a transmitter and receiver block diagram for the LVDS SERDES circuitry with the interface signals of the transmitter and receiver data paths.

Figure 5-33: LVDS SERDES



The preceding figure shows a shared PLL between the transmitter and receiver. If the transmitter and receiver do not share the same PLL, you require two fractional PLLs. In single data rate (SDR) and double data rate (DDR) modes, the data width is 1 and 2 bits, respectively.

Note: For the maximum data rate supported by the Cyclone V devices, refer to the device overview.

Related Information

- [Cyclone V Device Overview](#)
- [LVDS SERDES Transmitter/Receiver \(ALTLVDS_TX and ALTLVDS_RX\) Megafunction User Guide](#)
Provides a list of the LVDS transmitter and receiver ports and settings using ALTLVDS.
- [Guideline: Use PLLs in Integer PLL Mode for LVDS](#) on page 5-12

True LVDS Buffers in Cyclone V Devices

The Cyclone V device family supports LVDS on all I/O banks:

- Both row and column I/Os support true LVDS input buffers with R_D OCT and true LVDS output buffers.
- Cyclone V devices offer single-ended I/O reference clock support for the fractional PLL that drives the SERDES.

Note: True LVDS output buffers cannot be tri-stated.

The following tables list the number of true LVDS buffers supported in Cyclone V devices with these conditions:

- The LVDS channel count does not include dedicated clock pins.
- Each I/O sub-bank can support up to two independent ALTLVDS interfaces. For example, you can place two ALTLVDS interfaces in bank 8A driven by two different PLLs, provided that the LVDS channels are not interleaved.

Table 5-35: LVDS Channels Supported in Cyclone V E Devices—Preliminary

Member Code	Package	Side	TX	RX
A2 and A4	256-pin FineLine BGA	Top	8	8
		Left	4	4
		Right	8	8
		Bottom	12	12
	324-pin Ultra FineLine BGA	Top	12	12
		Left	8	8
		Right	8	8
		Bottom	16	16
	383-pin Micro FineLine BGA	Top	15	19
		Left	12	12
		Right	7	8
		Bottom	16	20
	484-pin Ultra FineLine BGA	Top	20	20
		Left	4	4
		Right	8	8
		Bottom	24	24
	484-pin FineLine BGA	Top	20	20
		Left	4	4
		Right	8	8
		Bottom	24	24

Member Code	Package	Side	TX	RX
A5	383-pin Micro FineLine BGA	Top	15	19
		Right	7	8
		Bottom	16	21
	484-pin Ultra FineLine BGA	Top	20	20
		Right	12	12
		Bottom	24	24
	484-pin FineLine BGA	Top	28	28
		Right	8	8
		Bottom	24	24
A7	484-pin Micro FineLine BGA	Top	20	20
		Right	16	16
		Bottom	24	24
	484-pin Ultra FineLine BGA	Top	20	20
		Right	16	16
		Bottom	24	24
	484-pin FineLine BGA	Top	28	28
		Right	8	8
		Bottom	24	24
	672-pin FineLine BGA	Top	28	28
		Right	24	24
		Bottom	32	32
	896-pin FineLine BGA	Top	40	40
		Right	40	40
		Bottom	40	40

Member Code	Package	Side	TX	RX
A9	484-pin Ultra FineLine BGA	Top	20	20
		Right	16	16
		Bottom	24	24
	484-pin FineLine BGA	Top	24	24
		Right	8	8
		Bottom	24	24
	672-pin FineLine BGA	Top	28	28
		Right	24	24
		Bottom	32	32
	896-pin FineLine BGA	Top	40	40
		Right	40	40
		Bottom	40	40

Table 5-36: LVDS Channels Supported in Cyclone V GX Devices—Preliminary

Member Code	Package	Side	TX	RX
C3	324-pin Ultra FineLine BGA	Top	12	12
		Right	8	8
		Bottom	16	16
	484-pin Ultra FineLine BGA	Top	20	20
		Right	8	8
		Bottom	24	24
	484-pin FineLine BGA	Top	20	20
		Right	8	8
		Bottom	24	24
C4	484-pin Ultra FineLine BGA	Top	20	20
		Right	12	12
		Bottom	24	24
	484-pin FineLine BGA	Top	28	28
		Right	8	8
		Bottom	24	24
	672-pin FineLine BGA	Top	28	28
		Right	24	24
		Bottom	32	32

Member Code	Package	Side	TX	RX
C5	301-pin Micro FineLine BGA	Top	6	15
		Right	7	8
		Bottom	8	20
	383-pin Micro FineLine BGA	Top	15	19
		Right	7	8
		Bottom	16	21
	484-pin Ultra FineLine BGA	Top	20	20
		Right	12	12
		Bottom	24	24
	484-pin FineLine BGA	Top	28	28
		Right	8	8
		Bottom	24	24
	672-pin FineLine BGA	Top	28	28
		Right	24	24
		Bottom	32	32
C7	484-pin Micro FineLine BGA	Top	20	20
		Right	16	16
		Bottom	24	24
	484-pin Ultra FineLine BGA	Top	20	20
		Right	16	16
		Bottom	24	24
	484-pin FineLine BGA	Top	28	28
		Right	8	8
		Bottom	24	24
	672-pin FineLine BGA	Top	28	28
		Right	24	24
		Bottom	32	32
	896-pin FineLine BGA	Top	40	40
		Right	40	40
		Bottom	40	40

Member Code	Package	Side	TX	RX
C9	484-pin Ultra FineLine BGA	Top	20	20
		Right	16	16
		Bottom	24	24
	484-pin FineLine BGA	Top	24	24
		Right	8	8
		Bottom	24	24
	672-pin FineLine BGA	Top	28	28
		Right	24	24
		Bottom	32	32
	896-pin FineLine BGA	Top	40	40
		Right	40	40
		Bottom	40	40
	1152-pin FineLine BGA	Top	48	48
		Right	44	44
		Bottom	48	48

Table 5-37: LVDS Channels Supported in Cyclone V GT Devices—Preliminary

Member Code	Package	Side	TX	RX
D5	301-pin Micro FineLine BGA	Top	6	15
		Right	7	8
		Bottom	8	20
	383-pin Micro FineLine BGA	Top	15	19
		Right	7	8
		Bottom	16	21
	484-pin Ultra FineLine BGA	Top	20	20
		Right	12	12
		Bottom	24	24
	484-pin FineLine BGA	Top	28	28
		Right	8	8
		Bottom	24	24
	672-pin FineLine BGA	Top	28	28
		Right	24	24
		Bottom	32	32

Member Code	Package	Side	TX	RX
D7	484-pin Micro FineLine BGA	Top	20	20
		Right	16	16
		Bottom	24	24
	484-pin Ultra FineLine BGA	Top	20	20
		Right	16	16
		Bottom	24	24
	484-pin FineLine BGA	Top	28	28
		Right	8	8
		Bottom	24	24
	672-pin FineLine BGA	Top	28	28
		Right	24	24
		Bottom	32	32
	896-pin FineLine BGA	Top	40	40
		Right	40	40
		Bottom	40	40
D9	484-pin Ultra FineLine BGA	Top	20	20
		Right	16	16
		Bottom	24	24
	484-pin FineLine BGA	Top	24	24
		Right	8	8
		Bottom	24	24
	672-pin FineLine BGA	Top	28	28
		Right	24	24
		Bottom	32	32
	896-pin FineLine BGA	Top	40	40
		Right	40	40
		Bottom	40	40
	1152-pin FineLine BGA	Top	48	48
		Right	44	44
		Bottom	48	48

Table 5-38: LVDS Channels Supported in Cyclone V SE Devices—Preliminary

Member Code	Package	Side	TX	RX
A2 and A4	484-pin Ultra FineLine BGA	Top	1	2
		Right	4	4
		Bottom	10	12
	672-pin Ultra FineLine BGA	Top	1	2
		Right	5	6
		Bottom	26	29
A5 and A6	484-pin Ultra FineLine BGA	Top	1	2
		Right	4	4
		Bottom	10	12
	672-pin Ultra FineLine BGA	Top	1	2
		Right	5	6
		Bottom	26	29
	896-pin FineLine BGA	Top	20	20
		Right	12	12
		Bottom	40	40

Table 5-39: LVDS Channels Supported in Cyclone V SX Devices—Preliminary

Member Code	Package	Side	TX	RX
C2 and C4	672-pin Ultra FineLine BGA	Top	1	2
		Right	5	6
		Bottom	26	29
C5 and C6	672-pin Ultra FineLine BGA	Top	1	2
		Right	5	6
		Bottom	26	29
	896-pin FineLine BGA	Top	20	20
		Right	12	12
		Bottom	40	40

Table 5-40: LVDS Channels Supported in Cyclone V ST Devices—Preliminary

Member Code	Package	Side	TX	RX
D5 and D6	896-pin FineLine BGA	Top	20	20
		Right	12	12
		Bottom	40	40

Related Information

Guideline: [Use PLLs in Integer PLL Mode for LVDS](#) on page 5-12

Emulated LVDS Buffers in Cyclone V Devices

The Cyclone V device family supports emulated LVDS on all I/O banks:

- You can use unutilized true LVDS input buffer as emulated LVDS output buffers (eTX), which use two single-ended output buffers with an external resistor network to support LVDS, mini-LVDS, and RSDS I/O standards.
- The emulated differential output buffers support tri-state capability.

Differential Transmitter in Cyclone V Devices

The Cyclone V transmitter contains dedicated circuitry to support high-speed differential signaling. The differential transmitter buffers support the following features:

- LVDS signaling that can drive out LVDS, mini-LVDS, and RSDS signals
- Programmable V_{OD} and programmable pre-emphasis

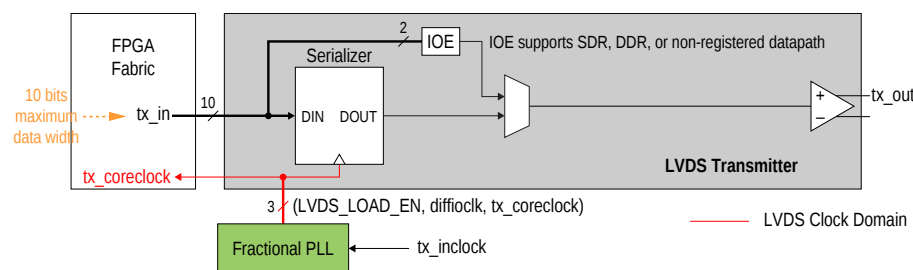
Transmitter Blocks

The dedicated circuitry consists of a true differential buffer, a serializer, and fractional PLLs that you can share between the transmitter and receiver. The serializer takes up to 10 bits wide parallel data from the FPGA fabric, clocks it into the load registers, and serializes it using shift registers that are clocked by the fractional PLL before sending the data to the differential buffer. The MSB of the parallel data is transmitted first.

Note: To drive the LVDS channels, you must use the PLLs in integer PLL mode.

The following figure shows a block diagram of the transmitter. In SDR and DDR modes, the data width is 1 and 2 bits, respectively.

Figure 5-34: LVDS Transmitter

**Related Information**

Guideline: [Use PLLs in Integer PLL Mode for LVDS](#) on page 5-12

Transmitter Clocking

The fractional PLL generates the parallel clocks (rx_outclock and tx_outclock), the load enable (LVDS_LOAD_EN) signal and the `diffioclk` signal (the clock running at serial data rate) that clocks the load and shift registers. You can statically set the serialization factor to x4, x5, x6, x7, x8, x9, or x10 using the Quartus II software. The load enable signal is derived from the serialization factor setting.

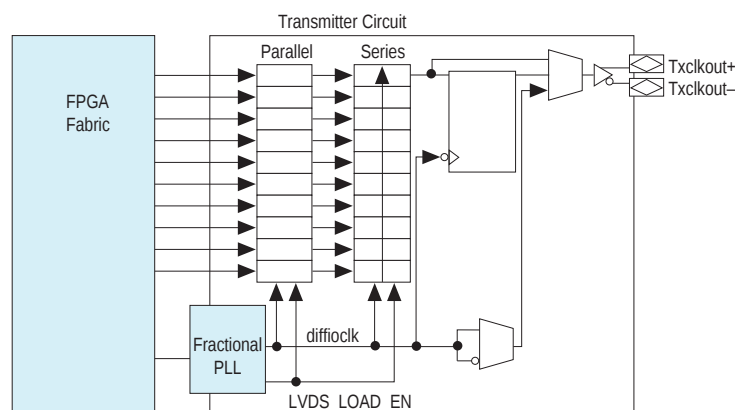
You can configure any Cyclone V transmitter data channel to generate a source-synchronous transmitter clock output. This flexibility allows the placement of the output clock near the data outputs to simplify board layout and reduce clock-to-data skew.

Different applications often require specific clock-to-data alignments or specific data-rate-to-clock-rate factors. You can specify these settings statically in the Quartus II MegaWizard Plug-In Manager:

- The transmitter can output a clock signal at the same rate as the data—with a maximum output clock frequency that each speed grade of the device supports.
- You can divide the output clock by a factor of 1, 2, 4, 6, 8, or 10, depending on the serialization factor.
- You can set the phase of the clock in relation to the data at 0° or 180° (edge- or center-aligned). The fractional PLLs provide additional support for other phase shifts in 45° increments.

The following figure shows the transmitter in clock output mode. In clock output mode, you can use an LVDS channel as a clock output channel.

Figure 5-35: Transmitter in Clock Output Mode



Related Information

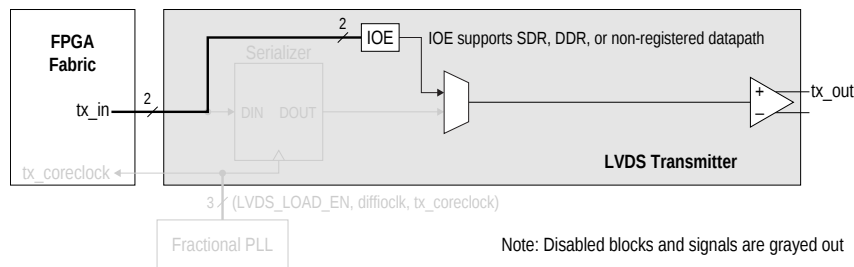
Guideline: Use PLLs in Integer PLL Mode for LVDS on page 5-12

Serializer Bypass for DDR and SDR Operations

You can bypass the serializer to support DDR (x2) and SDR (x1) operations to achieve a serialization factor of 2 and 1, respectively. The I/O element (IOE) contains two data output registers that can each operate in either DDR or SDR mode.

Figure 5-36: Serializer Bypass

This figure shows the serializer bypass path. In DDR mode, `tx_inclock` clocks the IOE register. In SDR mode, data is passed directly through the IOE. In SDR and DDR modes, the data width to the IOE is 1 and 2 bits, respectively.



Differential Receiver in Cyclone V Devices

The receiver has a differential buffer and fractional PLLs that you can share among the transmitter and receiver, a data realignment block, and a deserializer. The differential buffer can receive LVDS, mini-LVDS, and RSDS signal levels. You can statically set the I/O standard of the receiver pins to LVDS, SLVS, mini-LVDS, or RSDS in the Quartus II software Assignment Editor.

Note: To drive the LVDS channels, you must use the PLLs in integer PLL mode.

Related Information

Guideline: [Use PLLs in Integer PLL Mode for LVDS](#) on page 5-12

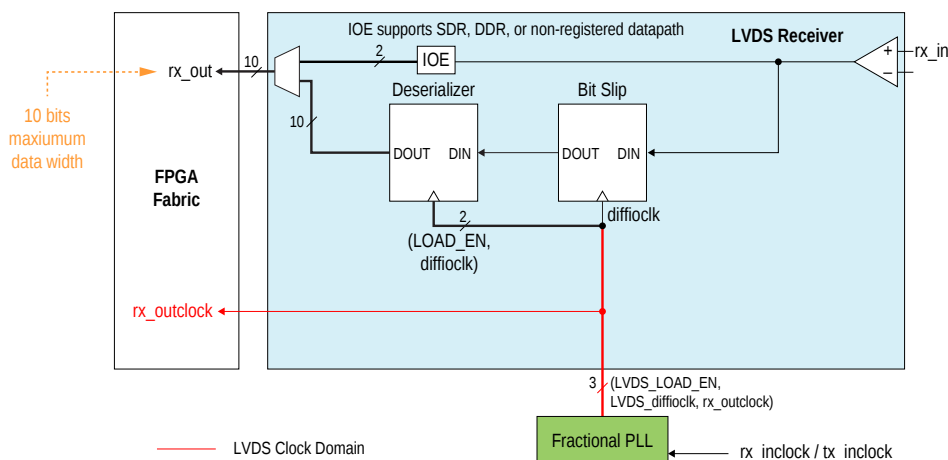
Receiver Blocks in Cyclone V Devices

The Cyclone V differential receiver has the following hardware blocks:

- Data realignment block (bit slip)
- Deserializer

The following figure shows the hardware blocks of the receiver. In SDR and DDR modes, the data width from the IOE is 1 and 2 bits, respectively. The deserializer includes shift registers and parallel load registers, and sends a maximum of 10 bits to the internal logic.

Figure 5-37: Receiver Block Diagram



Data Realignment Block (Bit Slip)

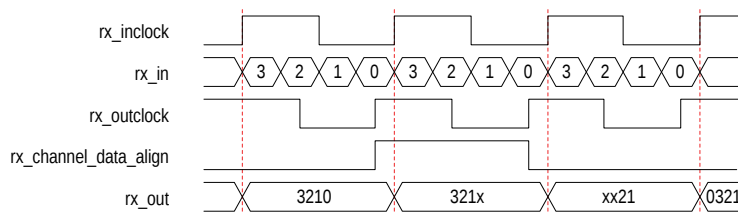
Skew in the transmitted data along with skew added by the link causes channel-to-channel skew on the received serial data streams. To compensate for this channel-to-channel skew and establish the correct received word boundary at each channel, each receiver channel has a dedicated data realignment circuit that realigns the data by inserting bit latencies into the serial stream.

An optional `RX_CHANNEL_DATA_ALIGN` port controls the bit insertion of each receiver independently controlled from the internal logic. The data slips one bit on the rising edge of `RX_CHANNEL_DATA_ALIGN`. The requirements for the `RX_CHANNEL_DATA_ALIGN` signal include the following items:

- The minimum pulse width is one period of the parallel clock in the logic array.
- The minimum low time between pulses is one period of the parallel clock.
- The signal is an edge-triggered signal.
- The valid data is available two parallel clock cycles after the rising edge of `RX_CHANNEL_DATA_ALIGN`.

Figure 5-38: Data Realignment Timing

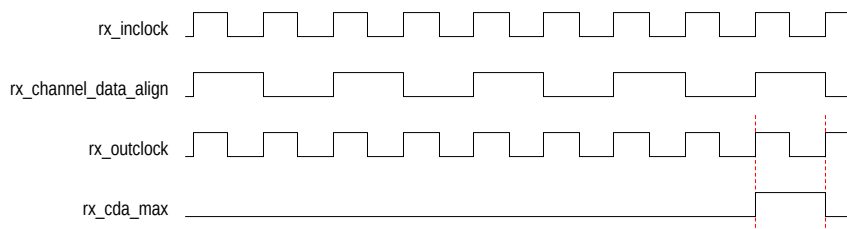
This figure shows receiver output (`RX_OUT`) after one bit slip pulse with the deserialization factor set to 4.



The data realignment circuit can have up to 11 bit-times of insertion before a rollover occurs. The programmable bit rollover point can be from 1 to 11 bit-times, independent of the deserialization factor. Set the programmable bit rollover point equal to, or greater than, the deserialization factor—allowing enough depth in the word alignment circuit to slip through a full word. You can set the value of the bit rollover point using the MegaWizard Plug-In Manager. An optional status port, `RX_CDA_MAX`, is available to the FPGA fabric from each channel to indicate the reaching of the preset rollover point.

Figure 5-39: Receiver Data Realignment Rollover

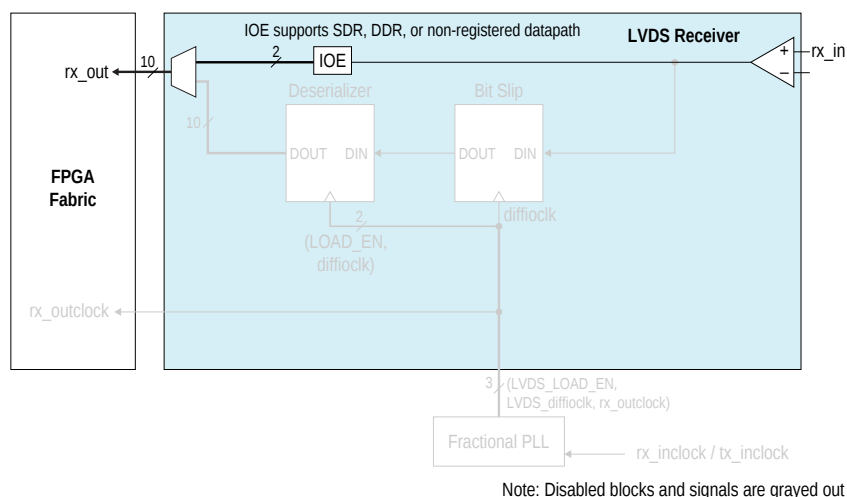
This figure shows a preset value of four bit-times before rollover occurs. The rx_cda_max signal pulses for one rx_outclock cycle to indicate that rollover has occurred.



Deserializer

You can statically set the deserialization factor to x4, x5, x6, x7, x8, x9, or x10 by using the Quartus II software. You can bypass the deserializer in the Quartus II MegaWizard Plug-In Manager to support DDR (x2) or SDR (x1) operations, as shown in the following figure.

Figure 5-40: Deserializer Bypass



The IOE contains two data input registers that can operate in DDR or SDR mode. In DDR mode, `rx_inclock` clocks the IOE register. In SDR mode, data is directly passed through the IOE. In SDR and DDR modes, the data width from the IOE is 1 and 2 bits, respectively.

Receiver Mode in Cyclone V Devices

The Cyclone V devices support the LVDS receiver mode.

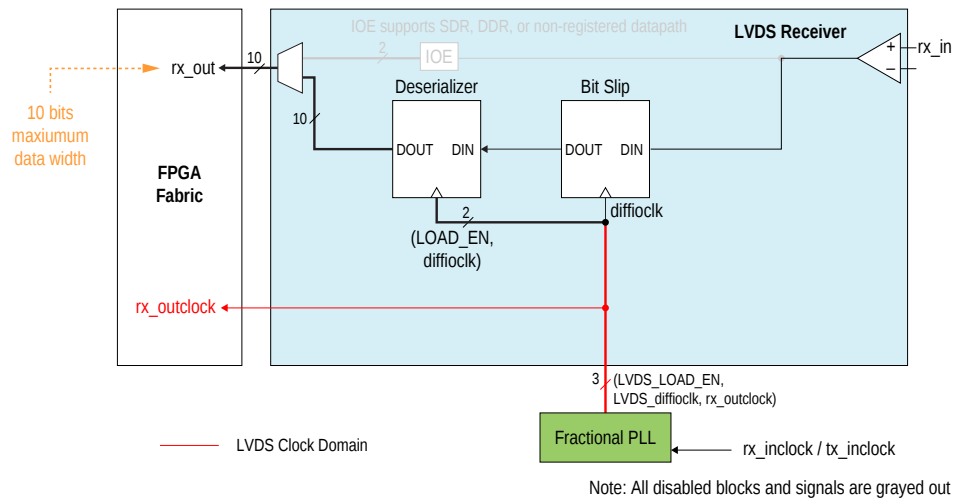
LVDS Receiver Mode

Input serial data is registered at the rising edge of the serial LVDS_diffioclk clock that is produced by the left and right PLLs.

You can select the rising edge option with the Quartus II MegaWizard Plug-In Manager. The `LVDS_diffioclk` clock that is generated by the left and right PLLs clocks the data realignment and deserializer blocks.

The following figure shows the LVDS datapath block diagram. In SDR and DDR modes, the data width from the IOE is 1 and 2 bits, respectively.

Figure 5-41: Receiver Data Path in LVDS Mode



Receiver Clocking for Cyclone V Devices

The fractional PLL receives the external clock input and generates different phases of the same clock.

The physical medium connecting the transmitter and receiver LVDS channels may introduce skew between the serial data and the source-synchronous clock. The instantaneous skew between each LVDS channel and the clock also varies with the jitter on the data and clock signals as seen by the receiver.

LVDS mode allows you to statically select the optimal phase between the source synchronous clock and the received serial data to compensate skew.

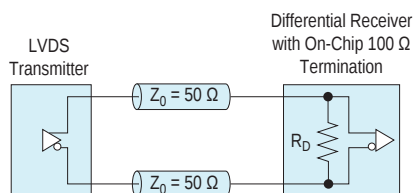
Related Information

Guideline: [Use PLLs in Integer PLL Mode for LVDS](#) on page 5-12

Differential I/O Termination for Cyclone V Devices

The Cyclone V devices provide a 100 Ω , on-chip differential termination option on each differential receiver channel for LVDS standards. On-chip termination saves board space by eliminating the need to add external resistors on the board. You can enable on-chip termination in the Quartus II software Assignment Editor.

All I/O pins and dedicated clock input pins support on-chip differential termination, R_D OCT.

Figure 5-42: On-Chip Differential I/O Termination**Table 5-41: Quartus II Software Assignment Editor—On-Chip Differential Termination**

This table lists the assignment name for on-chip differential termination in the Quartus II software Assignment Editor.

Field	Assignment
To	rx_in
Assignment name	Input Termination
Value	Differential

Source-Synchronous Timing Budget

The topics in this section describe the timing budget, waveforms, and specifications for source-synchronous signaling in the Cyclone V device family.

The LVDS I/O standard enables high-speed transmission of data, resulting in better overall system performance. To take advantage of fast system performance, you must analyze the timing for these high-speed signals. Timing analysis for the differential block is different from traditional synchronous timing analysis techniques.

The basis of the source synchronous timing analysis is the skew between the data and the clock signals instead of the clock-to-output setup times. High-speed differential data transmission requires the use of timing parameters provided by IC vendors and is strongly influenced by board skew, cable skew, and clock jitter.

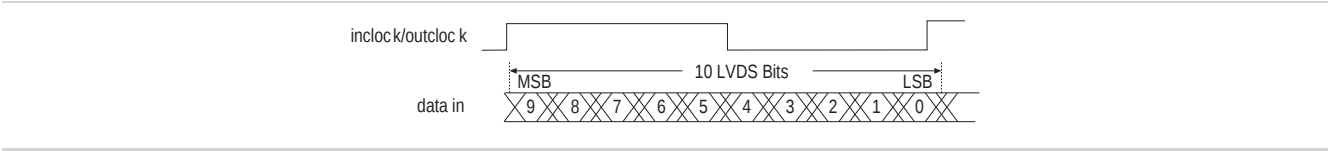
This section defines the source-synchronous differential data orientation timing parameters, the timing budget definitions for the Cyclone V device family, and how to use these timing parameters to determine the maximum performance of a design.

Differential Data Orientation

There is a set relationship between an external clock and the incoming data. For operations at 840 Mbps and a serialization factor of 10, the external clock is multiplied by 10. You can set phase-alignment in the PLL to coincide with the sampling window of each data bit. The data is sampled on the falling edge of the multiplied clock.

Figure 5-43: Bit Orientation in the Quartus II Software

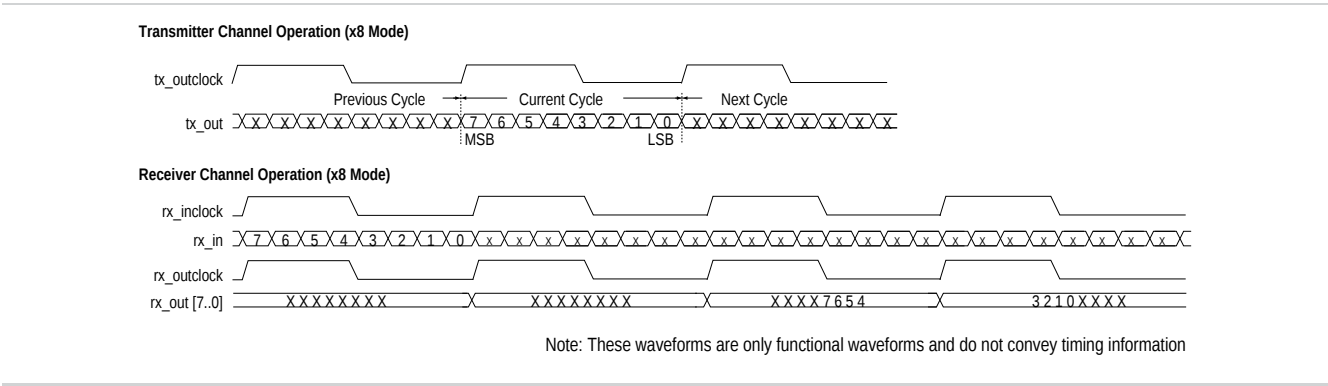
This figure shows the data bit orientation of the x10 mode.



Differential I/O Bit Position

- Data synchronization is necessary for successful data transmission at high frequencies.
- The following figure shows the data bit orientation for a channel operation and is based on the following conditions:
- The serialization factor is equal to the clock multiplication factor.
 - The phase alignment uses edge alignment.
 - The operation is implemented in hard SERDES.

Figure 5-44: Bit-Order and Word Boundary for One Differential Channel



For other serialization factors, use the Quartus II software tools to find the bit position within the word.

Differential Bit Naming Conventions

The following table lists the conventions for differential bit naming for 18 differential channels. The MSB and LSB positions increase with the number of channels used in a system.

Table 5-42: Differential Bit Naming

This table lists the conventions for differential bit naming for 18 differential channels, and the bit positions after deserialization.

Receiver Channel Data Number	Internal 8-Bit Parallel Data	
	MSB Position	LSB Position
1	7	0
2	15	8
3	23	16
4	31	24

Receiver Channel Data Number	Internal 8-Bit Parallel Data	
	MSB Position	LSB Position
5	39	32
6	47	40
7	55	48
8	63	56
9	71	64
10	79	72
11	87	80
12	95	88
13	103	96
14	111	104
15	119	112
16	127	120
17	135	128
18	143	136

Transmitter Channel-to-Channel Skew

The receiver skew margin calculation uses the transmitter channel-to-channel skew (TCCS)—an important parameter based on the Cyclone V transmitter in a source-synchronous differential interface:

- TCCS is the difference between the fastest and slowest data output transitions, including the T_{CO} variation and clock skew.
- For LVDS transmitters, the TimeQuest Timing Analyzer provides the TCCS value in the TCCS report (`report_TCCS`) in the Quartus II compilation report, which shows TCCS values for serial output ports.
- You can also get the TCCS value from the device datasheet.

Related Information

- [Cyclone V Device Datasheet](#)
- [LVDS SERDES Transmitter/Receiver \(ALTLVDS_TX and ALTLVDS_RX\) Megafunction User Guide](#)
Provides more information about the LVDS Transmitter/Receiver Package Skew Compensation report panel.

Receiver Skew Margin for LVDS Mode

In LVDS mode, use RSKM, TCCS, and sampling window (SW) specifications for high-speed source-synchronous differential signals in the receiver data path.

The following equation expresses the relationship between RSKM, TCCS, and SW.

Figure 5-45: RSKM Equation

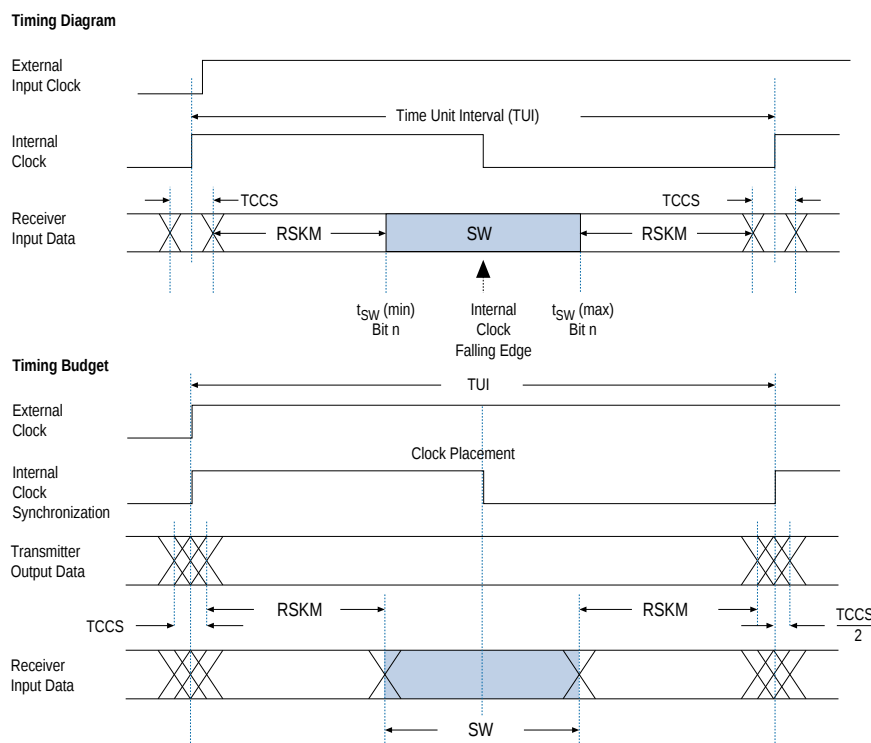
$$RSKM = \frac{TUI - SW - TCCS}{2}$$

Conventions used for the equation:

- RSKM—the timing margin between the receiver's clock input and the data input sampling window.
- Time unit interval (TUI)—time period of the serial data.
- SW—the period of time that the input data must be stable to ensure that data is successfully sampled by the LVDS receiver. The SW is a device property and varies with device speed grade.
- TCCS—the timing difference between the fastest and the slowest output edges, including t_{CO} variation and clock skew, across channels driven by the same PLL. The clock is included in the TCCS measurement.

You must calculate the RSKM value to decide whether the LVDS receiver can sample the data properly or not, given the data rate and device. A positive RSKM value indicates that the LVDS receiver can sample the data properly, whereas a negative RSKM indicates that it cannot sample the data properly.

The following figure shows the relationship between the RSKM, TCCS, and the SW of the receiver.

Figure 5-46: Differential High-Speed Timing Diagram and Timing Budget for LVDS Mode

For LVDS receivers, the Quartus II software provides an RSKM report showing the SW, TUI, and RSKM values for non-DPA LVDS mode:

- You can generate the RSKM report by executing the `report_RSKM` command in the TimeQuest Timing Analyzer. You can find the RSKM report in the Quartus II compilation report in the TimeQuest Timing Analyzer section.
- To obtain the RSKM value, assign the input delay to the LVDS receiver through the constraints menu of the TimeQuest Timing Analyzer. The input delay is determined according to the data arrival time at the LVDS receiver port, with respect to the reference clock.
- If you set the input delay in the settings parameters for the **Set Input Delay** option, set the clock name to the clock that reference the source synchronous clock that feeds the LVDS receiver.
- If you do not set any input delay in the TimeQuest Timing Analyzer, the receiver channel-to-channel skew defaults to zero.
- You can also directly set the input delay in a Synopsys Design Constraint file (`.sdc`) using the `set_input_delay` command.

Related Information

- [LVDS SERDES Transmitter/Receiver \(ALTLVDS_TX and ALTLVDS_RX\) Megafunction User Guide](#)
Provides more information about the RSKM equation and calculation.
- [Quartus II TimeQuest Timing Analyzer chapter, Quartus II Development Software Handbook](#)
Provides more information about `.sdc` commands and the TimeQuest Timing Analyzer.

Document Revision History

Date	Version	Changes
June 2013	2013.06.21	Updated the figure about data realignment timing to correct the data pattern after a bit slip.
June 2013	2013.06.17	<ul style="list-style-type: none"> • Removed 3.3 V input signal for 2.5 V V_{CCIO} in the table listing the MultiVolt I/O support. • Added a topic about LVDS I/O restrictions and differential pad placement rule. • Updated the preliminary I/O counts per bank for the following packages: <ul style="list-style-type: none"> • M301 packages of Cyclone V GX C5 and GT D5 devices. • U324 package of Cyclone V GX C3 device. • M383 packages of Cyclone V E A5, GX C5, and GT D5 devices. • M484 packages of Cyclone V E A7, GX C7, and GT D7 devices. • U484 packages of Cyclone V E A9, GX C9, and GT D9 devices. • F1152 packages of Cyclone V GX C9 and GT D9 devices. • Updated the preliminary LVDS channels counts for the M301 and M383 packages of Cyclone V E, GX, and GT devices.

Date	Version	Changes
		<ul style="list-style-type: none"> Added the preliminary LVDS channels counts for Cyclone V SE, SX, and ST devices. Updated the topic about LVDS input R_D OCT to remove the requirement for setting the V_{CCIO} to 2.5 V. R_D OCT now requires only that the V_{CCPD} is 2.5 V. Updated the topic about LVPECL termination to improve clarity.
May 2013	2013.05.06	<ul style="list-style-type: none"> Moved all links in all topics to the Related Information section for easy reference. Added link to the known document issues in the Knowledge Base. Updated the M386 package to M383. Updated the M383 package plan of the Cyclone V E device. Updated the GPIO count for the M301 package of the Cyclone V GX devices. Updated the HPS I/O counts for Cyclone V SE, SX, and ST devices. Updated the I/O vertical migration table. Corrected the note in the MultiVolt I/O interface topic. Updated the 3.3 V LVTTTL programmable current strength values to add 16 mA current strength. Removed statements indicating that the clock tree network cannot cross over to different I/O regions. Removed references to <code>rx_syncclock</code> port because the port does not apply to Cyclone V devices. Added Bank 1A to the I/O banks location figure for Cyclone V E devices because it is now available for the Cyclone V E A2 and A4 devices. Added the M383 and M484 packages to the modular I/O banks tables for Cyclone V E devices, and added the U484 package for the Cyclone V E A9 device. Added the U324, M301, M383, and M484 to the modular I/O banks tables for the Cyclone V GX devices, and added the U484 package for the Cyclone V GX C9 device. Added the M301, M383, and M484 to the modular I/O banks tables for the Cyclone V GT devices, and added the U484 package for the Cyclone V GT D9 device. Added notes to clarify the HPS row and column I/O counts in the modular I/O banks tables for the Cyclone V SE, SX, and ST devices. Changed the color of the transceiver blocks in the high-speed differential I/O location diagrams for clarity. Repaired the diagram for the example of calibrating multiple I/O banks with a shared OCT calibration block for readability. Added a topic about emulated LVDS buffers. Edited the topic about true LVDS buffers.

Date	Version	Changes
		<ul style="list-style-type: none"> Updated the tables listing the number of LVDS channels for the Cyclone V devices: <ul style="list-style-type: none"> Removed the F256 package from Cyclone V GX C3 device. Removed the F324 package from the Cyclone V GX C4 and C5, and Cyclone V GT D5 devices. Changed the F324 package of the Cyclone V GX C3 device to U324. Separated the Cyclone V GX C4 and C5 devices to different rows. Removed the F672 package from Cyclone V E A5. Added the M301 package to the Cyclone V GX C5 and Cyclone V GT D5 devices. Added the M383 package to the Cyclone V E A2, A4 and A4, Cyclone V GX C5, and Cyclone V GT D5 devices. Added the M484 package to the Cyclone V E A7, Cyclone V GX C7, and Cyclone V GT D7 devices. Added the U484 package to the Cyclone V E A9, Cyclone V GX C9, and Cyclone V GT D9 devices. Added the F484 package to the Cyclone V GX C9 and Cyclone V GT D9 devices. Updated the data realignment timing figure to improve clarity. Updated the receiver data realignment rollover figure to improve clarity.
December 2012	2012.12.28	<ul style="list-style-type: none"> Reorganized content and updated template. Added the I/O resources per package and I/O vertical migration sections for easy reference. Added the steps to verify pin migration compatibility using the Quartus II software. Updated the I/O standards support table with HPS I/O information. Added topic about the reference clock pin restriction for LVDS application. Updated the pin placement guideline for using LVDS differential channels. Added guideline about using the external PLL mode. Rearranged the I/O banks groups tables for easier reference. Removed statements that imply that V_{REF} pins can be used as normal I/Os. Updated the 3.3 V LVTTL programmable current strength values. Restructured the information in the topic about I/O buffers and registers to improve clarity and for faster reference. Added HPS information to the topic on programmable IOE features. Rearranged the tables about on-chip I/O termination for clarity and topic-based reference. Updated the high-speed differential I/O locations diagram for Cyclone V GX, SX, and ST devices.

Date	Version	Changes
		<ul style="list-style-type: none">• Removed statements about LVDS SERDES being available on top and bottom banks only.• Removed the topic about LVDS direct loopback mode.• Updated the true LVDS buffers count for Cyclone V E, GX, and GT devices.• Added the RSKM equation, description, and high-speed timing diagram.
June 2012	2.0	Updated for the Quartus II software v12.0 release: <ul style="list-style-type: none">• Restructured chapter.• Added “Design Considerations”, “VCCIO Restriction”, “LVDS Channels”, “Modular I/O Banks”, and “OCT Calibration Block” sections.• Added Figure 5–3, Figure 5–4, Figure 5–5, Figure 5–6, and Figure 5–27.• Updated Table 5–1, Table 5–8, and Table 5–10.• Updated Figure 5–22 with emulated LVDS with external single resistor.
February 2012	1.2	<ul style="list-style-type: none">• Updated Table 5–1, Table 5–2, Table 5–8, and Table 5–10.• Updated “I/O Banks” on page 5–8.• Minor text edits.
November 2011	1.1	<ul style="list-style-type: none">• Updated Table 5–2.• Updated Figure 5–3, Figure 5–4.• Updated “Sharing an OCT Calibration Block on Multiple I/O Banks”, “High-Speed Differential I/O Interfaces”, and “Fractional PLLs and Cyclone V Clocking” sections.
October 2011	1.0	Initial release.



External Memory Interfaces in Cyclone V Devices

6

2013.05.06

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The Cyclone V devices provide an efficient architecture that allows you to fit wide external memory interfaces to support a high level of system bandwidth within the small modular I/O bank structure. The I/Os are designed to provide high-performance support for existing and emerging external memory standards.

Table 6-1: Supported External Memory Standards in Cyclone V Devices

Memory Standard	Hard Memory Controller	Soft Memory Controller
DDR3 SDRAM	Full rate	Half rate
DDR2 SDRAM	Full rate	Half rate
LPDDR2 SDRAM	Full rate	Half rate

Related Information

- [External Memory Interface Spec Estimator](#)
To estimate the external memory system performance specification, use Altera's External Memory Interface Spec Estimator tool.
- [External Memory Interface Handbook](#)
Provides more information about the memory types supported, board design guidelines, timing analysis, simulation, and debugging information.
- [Cyclone V Device Handbook: Known Issues](#)
Lists the planned updates to the *Cyclone V Device Handbook* chapters.

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External Memory Performance

Table 6-2: External Memory Interface Performance in Cyclone V Devices

The maximum and minimum operating frequencies depend on the memory interface standards and the supported delay-locked loop (DLL) frequency listed in the device datasheet.

Interface	Voltage (V)	Maximum Frequency (MHz)		Minimum Frequency (MHz)
		Hard Controller	Soft Controller	
DDR3 SDRAM	1.5	400	300	300
	1.35	400	300	300
DDR2 SDRAM	1.8	400	300	167
LPDDR2 SDRAM	1.2	333	300	167

Related Information

[Cyclone V Device Datasheet](#)

HPS External Memory Performance

Table 6-3: HPS External Memory Interface Performance

The hard processor system (HPS) is available in Cyclone V SoC FPGA devices only.

Interface	Voltage (V)	HPS Hard Controller (MHz)
DDR3 SDRAM	1.5	400
	1.35	400
DDR2 SDRAM	1.8	400
	1.5	400
LPDDR2 SDRAM	1.2	333

Memory Interface Pin Support in Cyclone V Devices

In the Cyclone V devices, the memory interface circuitry is available in every I/O bank that does not support transceivers. The devices offer differential input buffers for differential read-data strobe and clock operations.

The memory clock pins are generated with double data rate input/output (DDRIO) registers.

Related Information

[Planning Pin and FPGA Resources chapter, External Memory Interface Handbook](#)

Provides more information about which pins to use for memory clock pins and pin location requirements.

Guideline: Using DQ/DQS Pins

The following list provides guidelines on using the DQ/DQS pins:

- The devices support DQ and DQS signals with DQ bus modes of x8 or x16. Cyclone V devices do not support the x4 bus mode.
- You can use the DQSn pins that are not used for clocking as DQ pins.
- If you do not use the DQ/DQS pins for memory interfacing, you can use these pins as user I/Os. However, unused HPS DQ/DQS pins on the Cyclone V SX and ST devices cannot be used as user I/Os.
- Some pins have multiple functions such as RZQ or DQ. If you need extra RZQ pins, you can use some of the DQ pins as RZQ pins instead.

Note: For the x8 or x16 DQ/DQS groups whose members are used as RZQ pins, Altera recommends that you assign the DQ and DQS pins manually. Otherwise, the Quartus II software might not be able to place the DQ and DQS pins, resulting in a “no-fit” error.

Reading the Pin Table

For the maximum number of DQ pins and the exact number per group for a particular Cyclone V device, refer to the relevant device pin table.

In the pin tables, the DQS and DQSn pins denote the differential data strobe/clock pin pairs. The DQS and DQSn pins are listed respectively in the Cyclone V pin tables as DQSXY and DQSnXY. X indicates the DQ/DQS grouping number and Y indicates whether the group is located on the top (T), bottom (B), left (L), or right (R) side of the device.

Note: The F484 package of the Cyclone V E A9, GX C9, and GT D9 devices can only support a 24 bit hard memory controller on the top side using the T_DQ_0 to T_DQ_23 pin assignments. Even though the F484 package pin tables of these devices list T_DQ_32 to T_DQ_39 in the “HMC Pin Assignment” columns, you cannot use these pin assignments for the hard memory controller.

Related Information

- [Hard Memory Controller Width for Cyclone V E](#) on page 6-34
- [Hard Memory Controller Width for Cyclone V GX](#) on page 6-35
- [Hard Memory Controller Width for Cyclone V GT](#) on page 6-36
- [Cyclone V Device Pin-Out Files](#)
Download the relevant pin tables from this web page.

DQ/DQS Bus Mode Pins for Cyclone V Devices

The following table lists the pin support per DQ/DQS bus mode, including the DQS and DQSn pin pairs. The maximum number of data pins per group listed in the table may vary according to the following conditions:

- Single-ended DQS signaling—the maximum number of DQ pins includes data mask connected to the DQS bus network.
- Differential or complementary DQS signaling—the maximum number of data pins per group decreases by one.
- DDR3 and DDR2 interfaces—each x8 group of pins require one DQS pin. You may also require one DQSn pin and one DM pin. This further reduces the total number of data pins available.

Table 6-4: DQ/DQS Bus Mode Pins for Cyclone V Devices

Mode	DQSn Support	Data Mask (Optional)	Maximum Data Pins per Group
x8	Yes	Yes	11
x16	Yes	Yes	23

DQ/DQS Groups in Cyclone V E

Table 6-5: Number of DQ/DQS Groups Per Side in Cyclone V E Devices

This table lists the DQ/DQS groups for the soft memory controller. For the hard memory controller, you can get the DQ/DQS groups from the pin table of the specific device. The numbers are preliminary before the devices are available.

Member Code	Package	Side	x8	x16
A2 A4	256-pin FineLine BGA	Top	2	0
		Left	1	0
		Right	2	0
		Bottom	3	0
	324-pin Ultra FineLine BGA	Top	3	0
		Left	2	0
		Right	2	0
		Bottom	4	0
	383-pin Micro FineLine BGA	Top	4	0
		Left	2	0
		Right	1	0
		Bottom	4	0
	484-pin Ultra FineLine BGA	Top	5	1
		Left	1	0
		Right	2	0
		Bottom	6	1
	484-pin FineLine BGA	Top	5	1
		Left	1	0
		Right	2	0
		Bottom	6	1

Member Code	Package	Side	x8	x16
A5	383-pin Micro FineLine BGA	Top	TBD	TBD
		Left	TBD	TBD
		Right	TBD	TBD
		Bottom	TBD	TBD
	484-pin Ultra FineLine BGA	Top	5	1
		Right	3	0
		Bottom	6	1
	484-pin FineLine BGA	Top	7	2
		Right	2	0
		Bottom	6	1
A7	484-pin Micro FineLine BGA	Top	5	1
		Right	4	0
		Bottom	6	1
	484-pin Ultra FineLine BGA	Top	5	1
		Right	4	1
		Bottom	6	1
	484-pin FineLine BGA	Top	7	2
		Right	2	0
		Bottom	6	1
	672-pin FineLine BGA	Top	7	2
		Right	6	0
		Bottom	8	2
	896-pin FineLine BGA	Top	10	3
		Right	10	3
		Bottom	10	3

Member Code	Package	Side	x8	x16
A9	484-pin Ultra FineLine BGA	Top	5	1
		Right	4	0
		Bottom	6	1
	484-pin FineLine BGA	Top	5	1
		Right	2	0
		Bottom	6	1
	672-pin FineLine BGA	Top	7	2
		Right	6	0
		Bottom	8	2
	896-pin FineLine BGA	Top	10	3
		Right	10	3
		Bottom	10	3

Related Information**Cyclone V Device Pin-Out Files**

Download the relevant pin tables from this web page.

DQ/DQS Groups in Cyclone V GX

Table 6-6: Number of DQ/DQS Groups Per Side in Cyclone V GX Devices

This table lists the DQ/DQS groups for the soft memory controller. For the hard memory controller, you can get the DQ/DQS groups from the pin table of the specific device. The numbers are preliminary before the devices are available.

Member Code	Package	Side	x8	x16
C3	324-pin Ultra FineLine BGA	Top	3	0
		Right	2	0
		Bottom	4	0
	484-pin Ultra FineLine BGA	Top	5	1
		Right	2	0
		Bottom	6	1
	484-pin FineLine BGA	Top	5	1
		Right	2	0
		Bottom	6	1

Member Code	Package	Side	x8	x16
C4 C5	301-pin Micro FineLine BGA	Top	TBD	TBD
		Left	TBD	TBD
		Right	TBD	TBD
		Bottom	TBD	TBD
	383-pin Micro FineLine BGA	Top	TBD	TBD
		Left	TBD	TBD
		Right	TBD	TBD
		Bottom	TBD	TBD
	484-pin Ultra FineLine BGA	Top	5	1
		Right	3	0
		Bottom	6	1
	484-pin FineLine BGA	Top	7	2
		Right	2	0
		Bottom	6	1
	672-pin FineLine BGA	Top	7	2
		Right	6	2
		Bottom	8	2
C7	484-pin Micro FineLine BGA	Top	5	1
		Right	4	0
		Bottom	6	1
	484-pin Ultra FineLine BGA	Top	5	1
		Right	4	1
		Bottom	6	1
	484-pin FineLine BGA	Top	7	2
		Right	2	0
		Bottom	6	1
	672-pin FineLine BGA	Top	7	2
		Right	6	0
		Bottom	8	2
	896-pin FineLine BGA	Top	10	3
		Right	10	3
		Bottom	10	3

Member Code	Package	Side	x8	x16
C9	484-pin Ultra FineLine BGA	Top	5	1
		Right	4	0
		Bottom	6	1
	484-pin FineLine BGA	Top	5	1
		Right	2	0
		Bottom	6	1
	672-pin FineLine BGA	Top	7	2
		Right	6	0
		Bottom	8	2
	896-pin FineLine BGA	Top	10	3
		Right	10	3
		Bottom	10	3
	1152-pin FineLine BGA	Top	12	4
		Right	11	4
		Bottom	12	4

Related Information**[Cyclone V Device Pin-Out Files](#)**

Download the relevant pin tables from this web page.

DQ/DQS Groups in Cyclone V GT

Table 6-7: Number of DQ/DQS Groups Per Side in Cyclone V GT Devices

This table lists the DQ/DQS groups for the soft memory controller. For the hard memory controller, you can get the DQ/DQS groups from the pin table of the specific device. The numbers are preliminary before the devices are available.

Member Code	Package	Side	x8	x16
D5	301-pin Micro FineLine BGA	Top	TBD	TBD
		Left	TBD	TBD
		Right	TBD	TBD
		Bottom	TBD	TBD
	383-pin Micro FineLine BGA	Top	TBD	TBD
		Left	TBD	TBD
		Right	TBD	TBD
		Bottom	TBD	TBD
	484-pin Ultra FineLine BGA	Top	5	1
		Right	3	0
		Bottom	6	1
	484-pin FineLine BGA	Top	7	2
		Right	2	0
		Bottom	6	1
	672-pin FineLine BGA	Top	7	2
		Right	6	2
		Bottom	8	2

Member Code	Package	Side	x8	x16
D7	484-pin Micro FineLine BGA	Top	5	1
		Right	4	0
		Bottom	6	1
	484-pin Ultra FineLine BGA	Top	5	1
		Right	4	1
		Bottom	6	1
	484-pin FineLine BGA	Top	7	2
		Right	2	0
		Bottom	6	1
	672-pin FineLine BGA	Top	7	2
		Right	6	0
		Bottom	8	2
	896-pin FineLine BGA	Top	10	3
		Right	10	3
		Bottom	10	3
D9	484-pin Ultra FineLine BGA	Top	5	1
		Right	4	0
		Bottom	6	1
	484-pin FineLine BGA	Top	5	1
		Right	2	0
		Bottom	6	1
	672-pin FineLine BGA	Top	7	2
		Right	6	0
		Bottom	8	2
	896-pin FineLine BGA	Top	10	3
		Right	10	3
		Bottom	10	3
	1152-pin FineLine BGA	Top	12	4
		Right	11	4
		Bottom	12	4

Related Information**Cyclone V Device Pin-Out Files**

Download the relevant pin tables from this web page.

DQ/DQS Groups in Cyclone V SX

Table 6-8: Number of DQ/DQS Groups Per Side in Cyclone V SX Devices

This table lists the DQ/DQS groups for the soft memory controller. For the hard memory controller, you can get the DQ/DQS groups from the pin table of the specific device. The numbers are preliminary before the devices are available.

Member Code	Package	Side	x8	x16
C2	672-pin Ultra FineLine BGA	Right	1	0
C4		Bottom	8	2
C5	672-pin Ultra FineLine BGA	Right	1	0
		Bottom	8	2
C6	896-pin FineLine BGA	Top	5	2
		Right	3	0
		Bottom	10	3

Related Information

[Cyclone V Device Pin-Out Files](#)

Download the relevant pin tables from this web page.

DQ/DQS Groups in Cyclone V ST

Table 6-9: Number of DQ/DQS Groups Per Side in Cyclone V ST Devices

This table lists the DQ/DQS groups for the soft memory controller. For the hard memory controller, you can get the DQ/DQS groups from the pin table of the specific device. The numbers are preliminary before the devices are available.

Member Code	Package	Side	x8	x16
D5	896-pin FineLine BGA	Top	5	2
D6		Right	3	0
		Bottom	10	3

Related Information

[Cyclone V Device Pin-Out Files](#)

Download the relevant pin tables from this web page.

External Memory Interface Features in Cyclone V Devices

The Cyclone V I/O elements (IOE) provide built-in functionality required for a rapid and robust implementation of external memory interfacing.

The following device features are available for external memory interfaces:

- DQS phase-shift circuitry
- PHY Clock (PHYCLK) networks
- DQS logic block
- Dynamic on-chip termination (OCT) control
- IOE registers
- Delay chains
- Hard memory controllers

UniPHY IP

The high-performance memory interface solution includes the self-calibrating UniPHY IP that is optimized to take advantage of the Cyclone V I/O structure and the Quartus II software TimeQuest Timing Analyzer. The UniPHY IP helps set up the physical interface (PHY) best suited for your system. This provides the total solution for the highest reliable frequency of operation across process, voltage, and temperature (PVT) variations.

The UniPHY IP instantiates a PLL to generate related clocks for the memory interface. The UniPHY IP can also dynamically choose the number of delay chains that are required for the system. The amount of delay is equal to the sum of the intrinsic delay of the delay element and the product of the number of delay steps and the value of the delay steps.

The UniPHY IP and the Altera memory controller MegaCore[®] functions can run at half the I/O interface frequency of the memory devices, allowing better timing management in high-speed memory interfaces. The Cyclone V devices contain built-in circuitry in the IOE to convert data from full rate (the I/O frequency) to half rate (the controller frequency) and vice versa.

Related Information

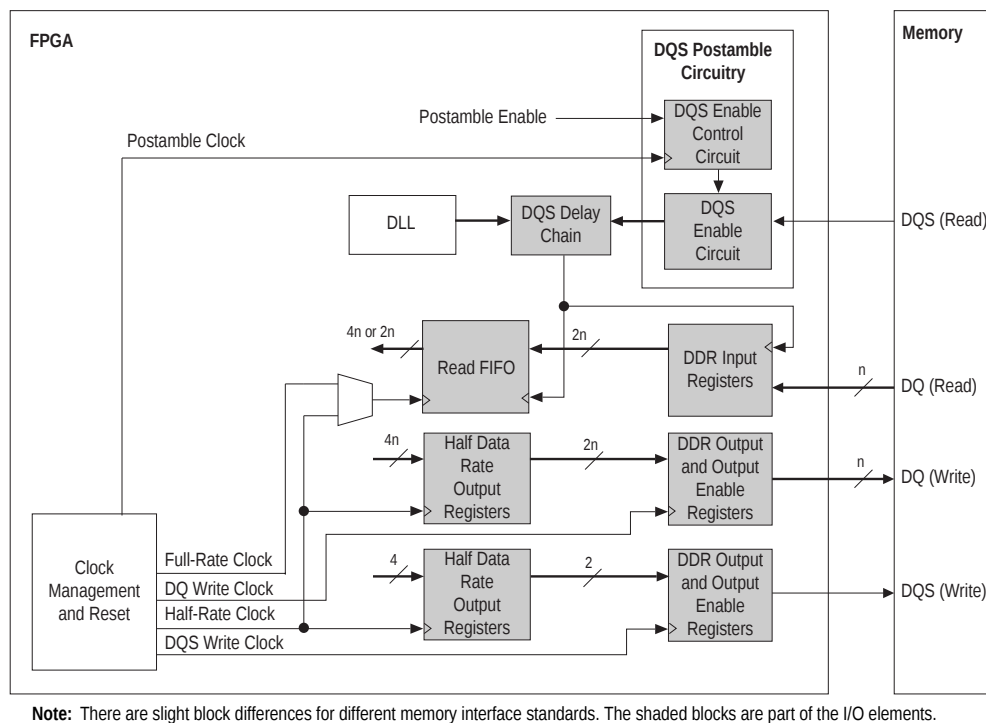
[Reference Material volume, External Memory Interface Handbook](#)

Provides more information about the UniPHY IP.

External Memory Interface Datapath

The following figure shows an overview of the memory interface datapath that uses the Cyclone V I/O elements. In the figure, the DQ/DQS read and write signals may be bidirectional or unidirectional, depending on the memory standard. If the signal is bidirectional, it is active during read and write operations. You can bypass each register block.

Figure 6-1: External Memory Interface Datapath Overview for Cyclone V Devices



DQS Phase-Shift Circuitry

The Cyclone V DLL provides phase shift to the DQS pins on read transactions if the DQS pins are acting as input clocks or strobes to the FPGA.

The following figures show how the DLLs are connected to the DQS pins in the various Cyclone V variants. The reference clock for each DLL may come from adjacent PLLs.

Note: The following figures show all possible connections for each device. For available pins and connections in each device package, refer to the device pin-out files.

Figure 6-2: DQS Pins and DLLs in Cyclone V E (A2 and A4) Devices

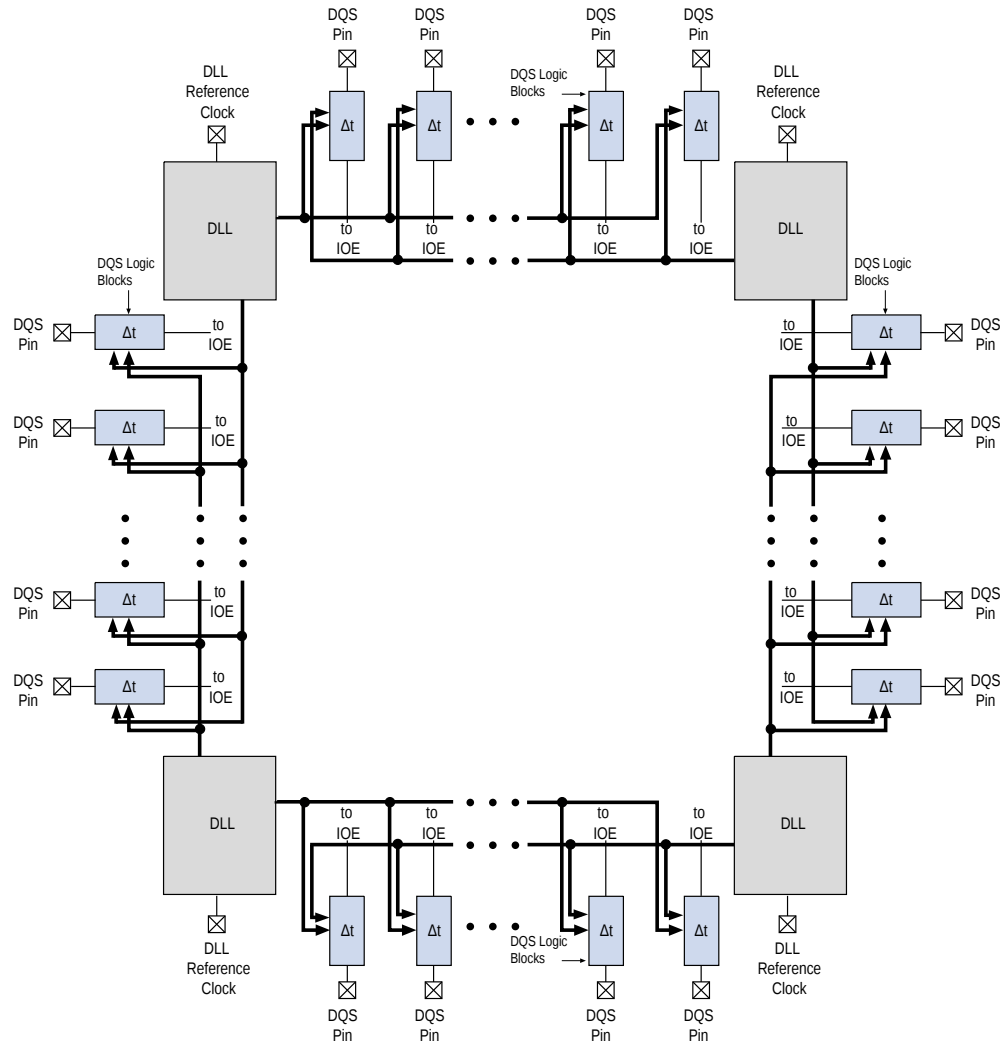


Figure 6-3: DQS Pins and DLLs in Cyclone V GX (C3) Devices

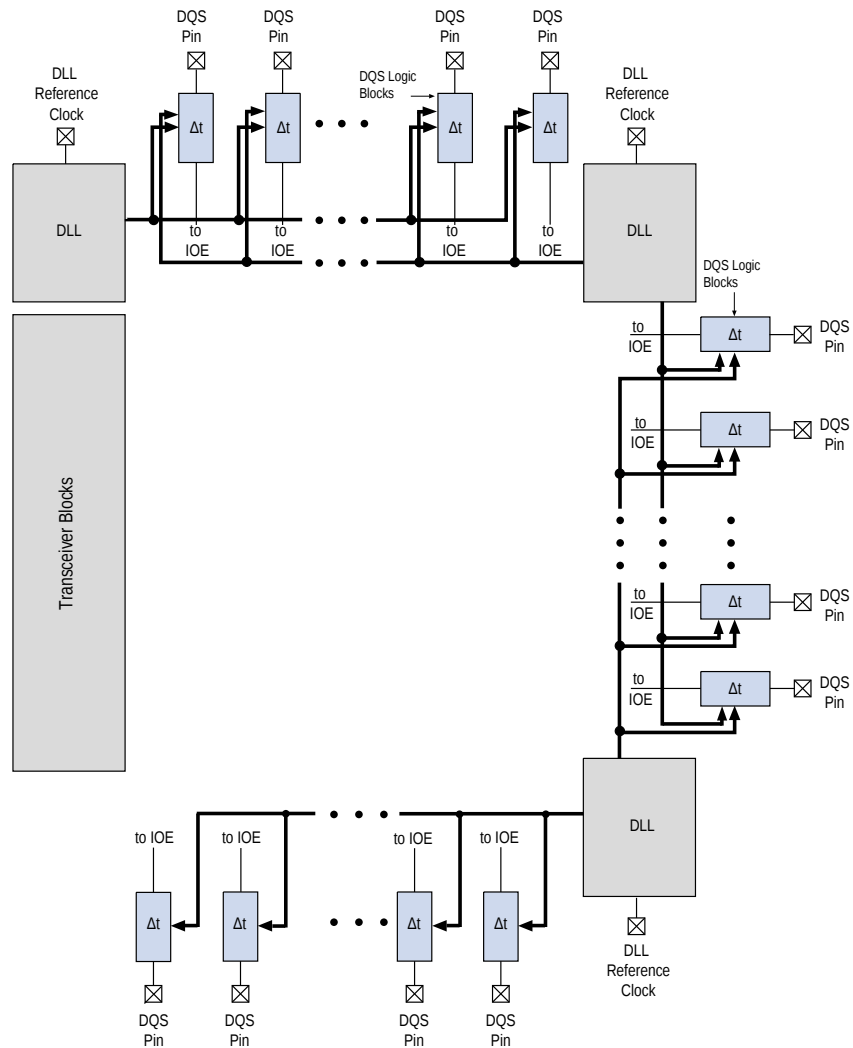


Figure 6-4: DQS Pins and DLLs in Cyclone V E (A5, A7, and A9), GX (C4, C5, C7, and C9), GT (D5, D7, and D9) Devices

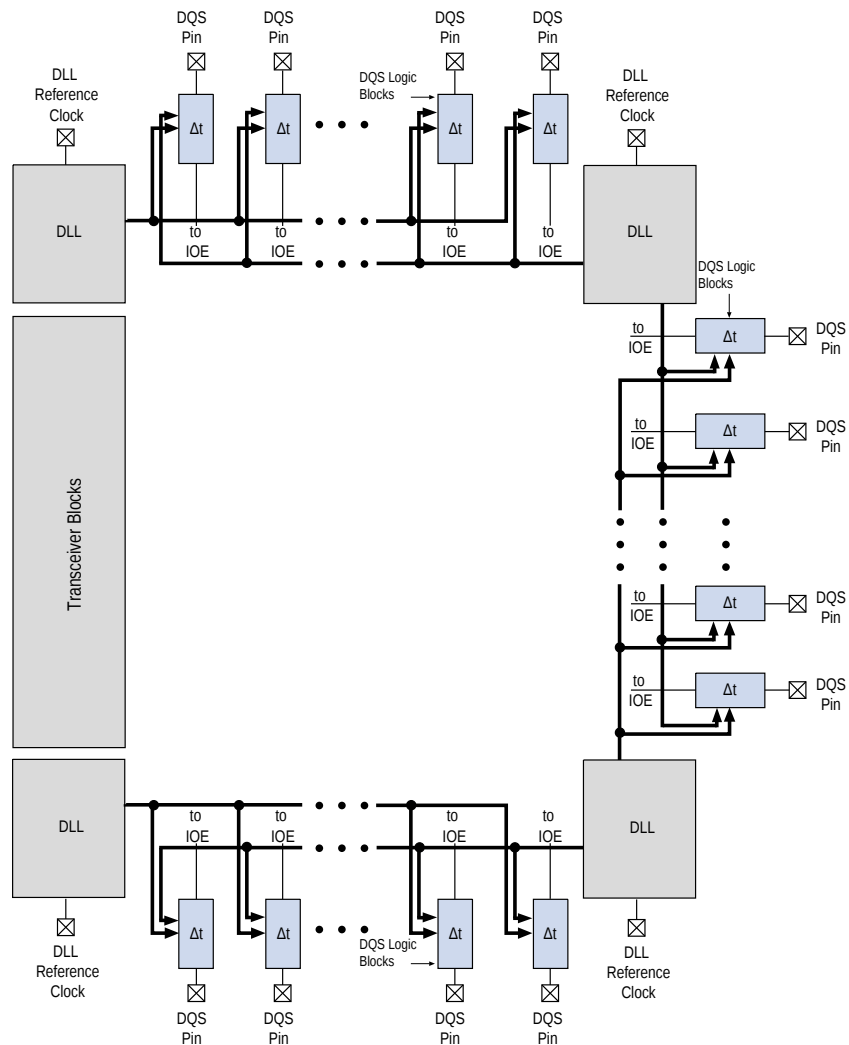
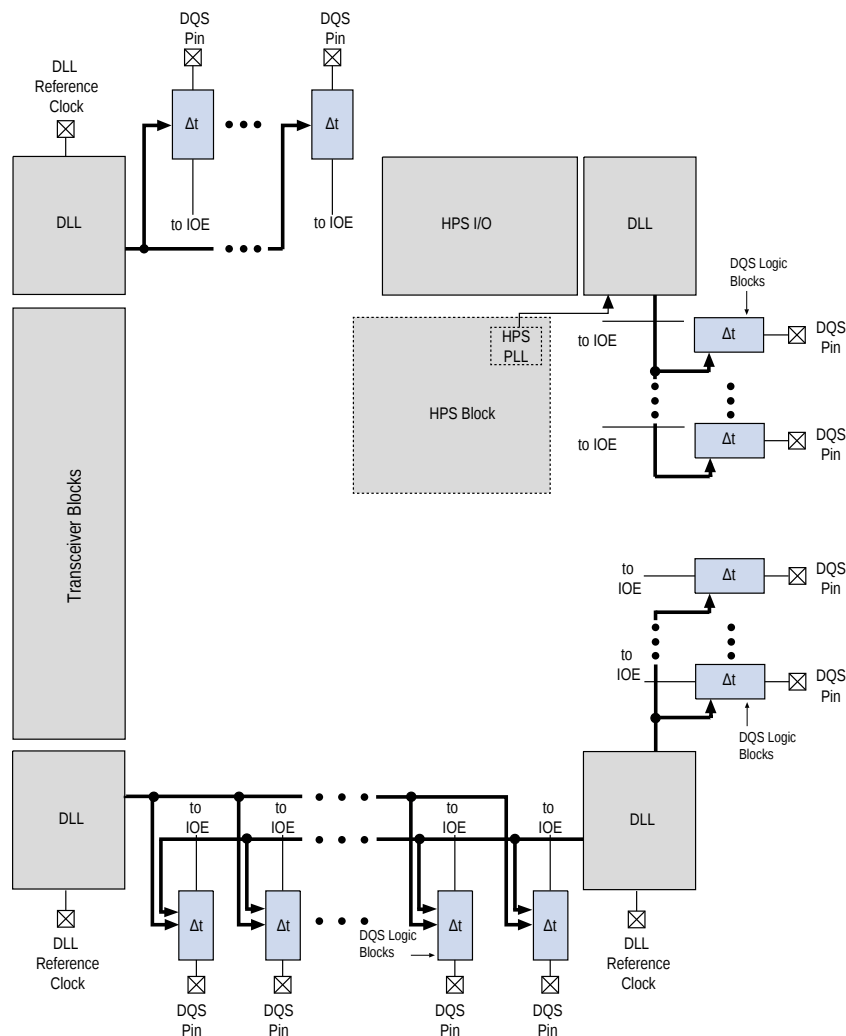


Figure 6-6: DQS Pins and DLLs in Cyclone V SX (C2, C4, C5, and C6) and ST (D5 and D6) Devices

**Related Information****Cyclone V Device Pin-Out Files**

Download the relevant pin tables from this web page.

Delay-Locked Loop

The delay-locked loop (DLL) uses a frequency reference to dynamically generate control signals for the delay chains in each of the DQS pins, allowing the delay to compensate for process, voltage, and temperature (PVT) variations. The DQS delay settings are Gray-coded to reduce jitter if the DLL updates the settings.

There are a maximum of four DLLs, located in each corner of the Cyclone V devices. You can clock each DLL using different frequencies.

The DLLs can access the two adjacent sides from its location in the device. You can have two different interfaces with the same frequency on the two sides adjacent to a DLL, where the DLL controls the DQS delay settings for both interfaces.

I/O banks between two DLLs have the flexibility to create multiple frequencies and multiple-type interfaces. These banks can use settings from either or both adjacent DLLs. For example, DQS1R can get its phase-shift settings from DLL_TR, while DQS2R can get its phase-shift settings from DLL_BR.

The reference clock for each DLL may come from the PLL output clocks or clock input pins.

Note: If you have a dedicated PLL that only generates the DLL input reference clock, set the PLL mode to **Direct Compensation** to achieve better performance (or the Quartus II software automatically changes it). Because the PLL does not use any other outputs, it does not have to compensate for any clock paths.

DLL Reference Clock Input for Cyclone V Devices

Table 6-10: DLL Reference Clock Input from PLLs for Cyclone V E (A2, A4, A5, A7, and A9), GX (C4, C5, C7, and C9), and GT (D5, D7, and D9) Devices—Preliminary

DLL	PLL			
	Top Left	Top Right	Bottom Left	Bottom Right
DLL_TL	pllout	—	—	—
DLL_TR	—	pllout	—	—
DLL_BL	—	—	pllout	—
DLL_BR	—	—	—	pllout

Table 6-11: DLL Reference Clock Input from PLLs for Cyclone V GX (C3) Device—Preliminary

DLL	PLL			
	Top Left	Top Right	Bottom Left	Bottom Right
DLL_TL	pllout	—	—	—
DLL_TR	—	pllout	—	—
DLL_BL	—	—	—	—
DLL_BR	—	—	—	pllout

Table 6-12: DLL Reference Clock Input from PLLs for Cyclone V SX C2, C4, C5, and C6 Devices, and Cyclone V ST D5 and D6 Devices—Preliminary

DLL	PLL			
	Top Left	Top Right	Bottom Left	Bottom Right
DLL_TL	pllout	—	—	—
DLL_TR	—	—	—	—
DLL_BL	—	—	pllout	—

DLL	PLL			
	Top Left	Top Right	Bottom Left	Bottom Right
DLL_BR	—	—	—	pllout

DLL Phase-Shift

The DLL can shift the incoming DQS signals by 0° or 90°. The shifted DQS signal is then used as the clock for the DQ IOE input registers, depending on the number of DQS delay chains used.

All DQS pins, referenced to the same DLL, can have their input signal phase shifted by a different degree amount but all must be referenced at one particular frequency. However, not all phase-shift combinations are supported. The phase shifts on the DQS pins referenced by the same DLL must all be a multiple of 90°.

The 7-bit DQS delay settings from the DLL vary with PVT to implement the phase-shift delay.

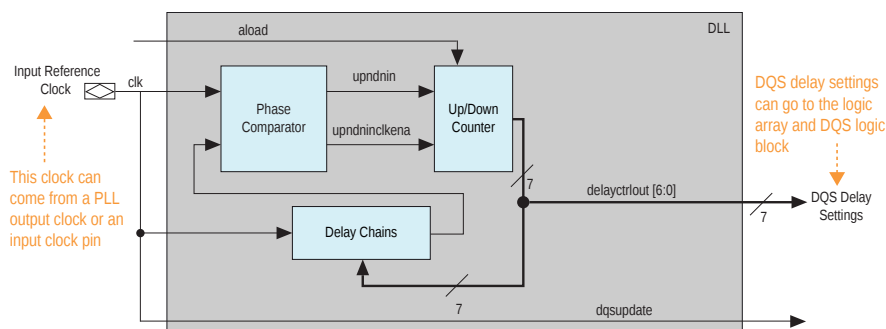
For example, with a 0° shift, the DQS signal bypasses both the DLL and DQS logic blocks. The Quartus II software automatically sets the DQ input delay chains, so that the skew between the DQ and DQS pins at the DQ IOE registers is negligible if a 0° shift is implemented. You can feed the DQS delay settings to the DQS logic block and logic array.

The shifted DQS signal goes to the DQS bus to clock the IOE input registers of the DQ pins. The signal can also go into the logic array for resynchronization if you are not using IOE read FIFO for resynchronization.

For Cyclone V SoC FPGAs, you can feed the hard processor system (HPS) DQS delay settings to the HPS DQS logic block only.

The following figure shows a simple block diagram of the DLL in the Cyclone V devices. All features of the DQS phase-shift circuitry are accessible from the UniPHY megafunction in the Quartus II software.

Figure 6-7: Simplified Diagram of the DQS Phase-Shift Circuitry



The input reference clock goes into the DLL to a chain of up to eight delay elements. The phase comparator compares the signal coming out of the end of the delay chain block to the input reference clock. The phase comparator then issues the `updn` signal to the Gray-code counter. This signal increments or decrements a 7-bit delay setting (DQS delay settings) that increases or decreases the delay through the delay element chain to bring the input reference clock and the signals coming out of the delay element chain in phase.

The DLL can be reset from either the logic array or a user I/O pin. Each time the DLL is reset, you must wait for 2,560 clock cycles for the DLL to lock before you can capture the data properly. The DLL phase comparator requires 2,560 clock cycles to lock and calculate the correct input clock period.

For the frequency range of each DLL frequency mode, refer to the device datasheet.

Related Information

[Cyclone V Device Datasheet](#)

PHY Clock (PHYCLK) Networks

The PHYCLK network is a dedicated high-speed, low-skew balanced clock tree designed for a high-performance external memory interface.

The top and bottom sides of the Cyclone V devices have up to four PHYCLK networks each. There are up to two PHYCLK networks on the left and right side I/O banks. Each PHYCLK network spans across one I/O bank and is driven by one of the PLLs located adjacent to the I/O bank.

The following figures show the PHYCLK networks available in the Cyclone V devices.

Figure 6-8: PHYCLK Networks in Cyclone V E A2 and A4 Devices

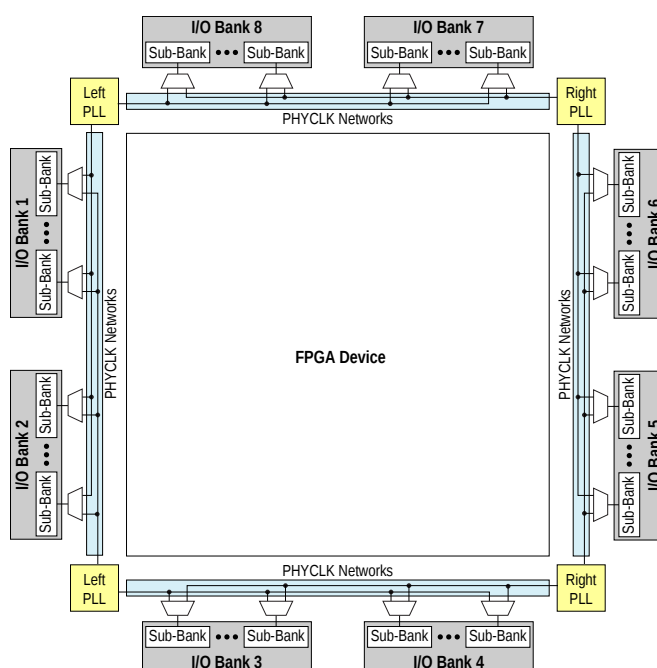


Figure 6-9: PHYCLK Networks in Cyclone V GX C3 Devices

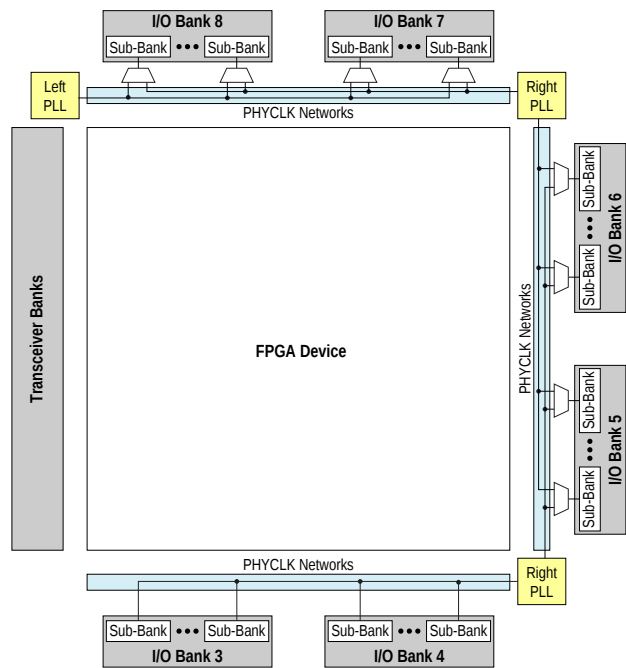


Figure 6-10: PHYCLK Networks in Cyclone V E A7, A5, and A9 Devices, Cyclone V GX C4, C5, C7, and C9 Devices, and Cyclone V GT D5, D7, and D9 Devices

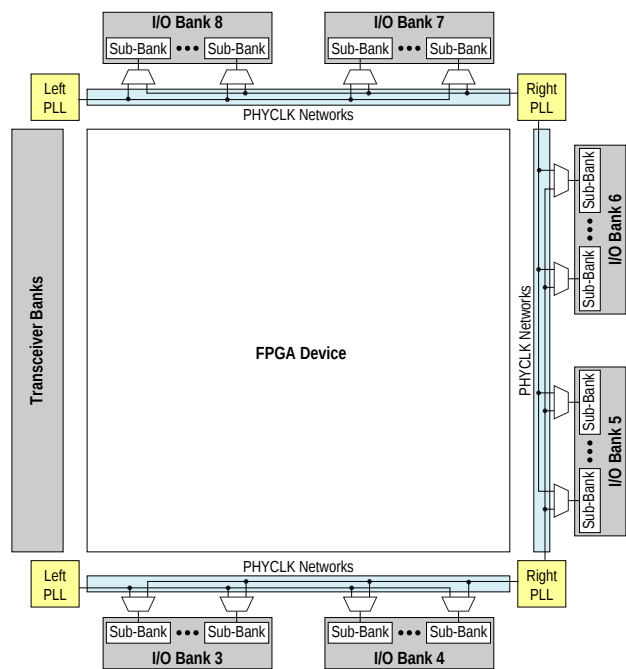
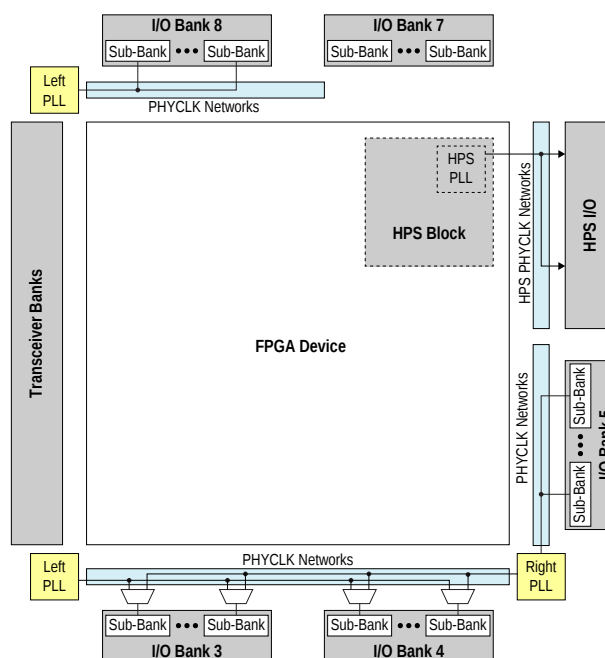


Figure 6-12: PHYCLK Networks in Cyclone V SX C2, C4, C5, and C6 Devices, and Cyclone V ST D5 and D6 Devices

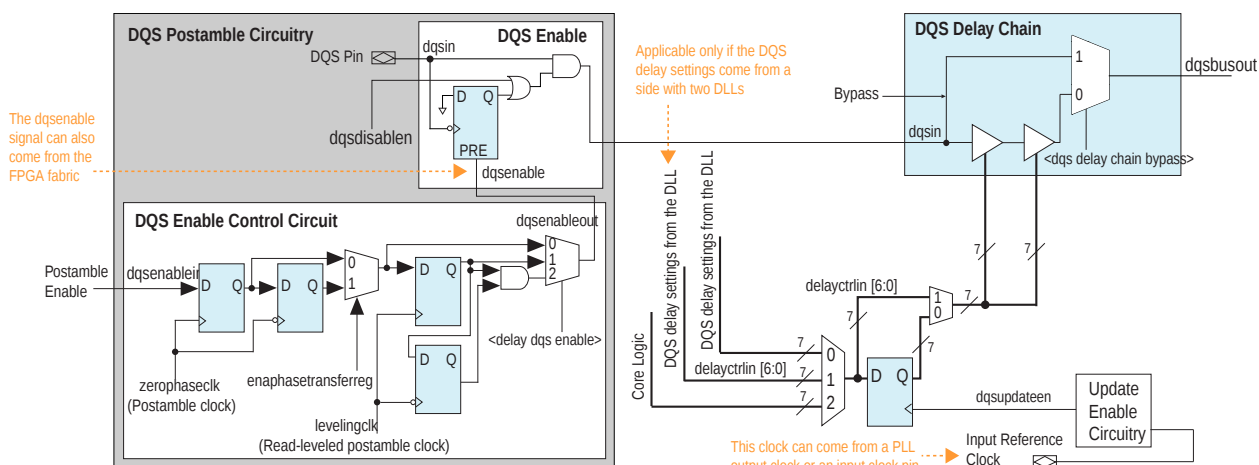


DQS Logic Block

Each DQS/CQ/CQn/QK# pin is connected to a separate DQS logic block, which consists of the update enable circuitry, DQS delay chains, and DQS postamble circuitry.

The following figure shows the DQS logic block.

Figure 6-13: DQS Logic Block in Cyclone V Devices



Update Enable Circuitry

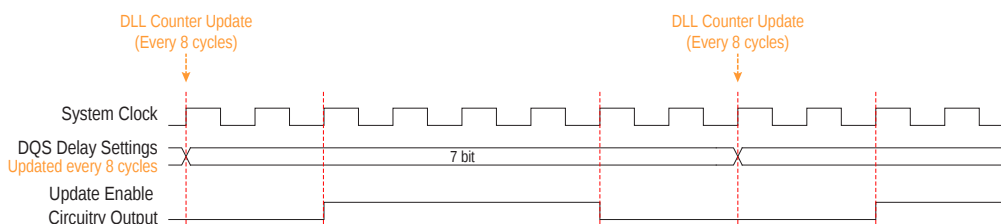
The update enable circuitry enables the registers to allow enough time for the DQS delay settings to travel from the DQS phase-shift circuitry or core logic to all the DQS logic blocks before the next change.

Both the DQS delay settings and the phase-offset settings pass through a register before going into the DQS delay chains. The registers are controlled by the update enable circuitry to allow enough time for any changes in the DQS delay setting bits to arrive at all the delay elements, which allows them to be adjusted at the same time.

The circuitry uses the input reference clock or a user clock from the core to generate the update enable output. The UniPHY intellectual property (IP) uses this circuit by default.

Figure 6-14: DQS Update Enable Waveform

This figure shows an example waveform of the update enable circuitry output.



DQS Delay Chain

DQS delay chains consist of a set of variable delay elements to allow the input DQS signals to be shifted by the amount specified by the DQS phase-shift circuitry or the logic array.

There are two delay elements in the DQS delay chain that have the same characteristics:

- Delay elements in the DQS logic block
- Delay elements in the DLL

The DQS pin is shifted by the DQS delay settings.

The number of delay chains required is transparent because the UniPHY IP automatically sets it when you choose the operating frequency.

In Cyclone V E, GX, and GT devices, if you do not use the DLL to control the DQS delay chains, you can input your own Gray-coded 7 bit settings using the `delayctrlin[6..0]` signals available in the UniPHY IP.

In the Cyclone V SE, SX, and ST devices, the DQS delay chain is controlled by the DQS phase-shift circuitry only.

DQS Postamble Circuitry

There are preamble and postamble specifications for both read and write operations in DDR3 and DDR2 SDRAM. The DQS postamble circuitry ensures that data is not lost if there is noise on the DQS line during the end of a read operation that occurs while DQS is in a postamble state.

The Cyclone V devices contain dedicated postamble registers that you can control to ground the shifted DQS signal that is used to clock the DQ input registers at the end of a read operation. This function ensures

that any glitches on the DQS input signal during the end of a read operation and occurring while DQS is in a postamble state do not affect the DQ IOE registers.

- For preamble state, the DQS is low, just after a high-impedance state.
- For postamble state, the DQS is low, just before it returns to a high-impedance state.

For external memory interfaces that use a bidirectional read strobe (DDR3 and DDR2 SDRAM), the DQS signal is low before going to or coming from a high-impedance state.

Half Data Rate Block

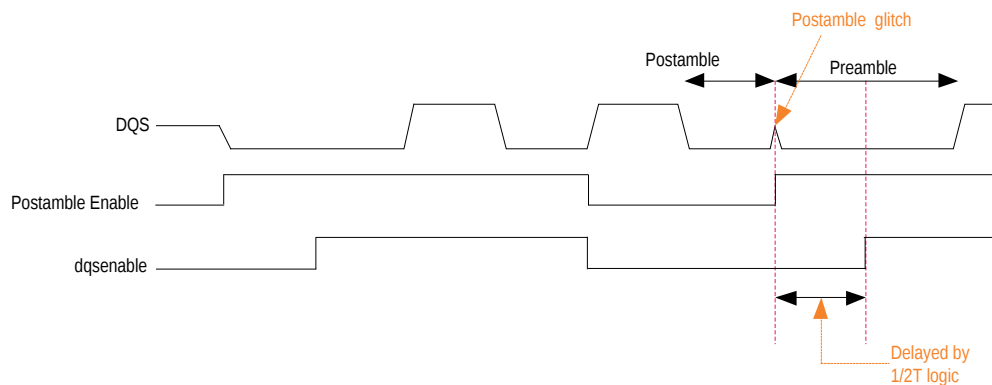
The Cyclone V devices contain a half data rate (HDR) block in the postamble enable circuitry.

The HDR block is clocked by the half-rate resynchronization clock, which is the output of the I/O clock divider circuit. There is an AND gate after the postamble register outputs to avoid postamble glitches from a previous read burst on a non-consecutive read burst. This scheme allows half-a-clock cycle latency for `dqsenable` assertion and zero latency for `dqsenable` deassertion.

Using the HDR block as the first stage capture register in the postamble enable circuitry block is optional. Altera recommends using these registers if the controller is running at half the frequency of the I/Os.

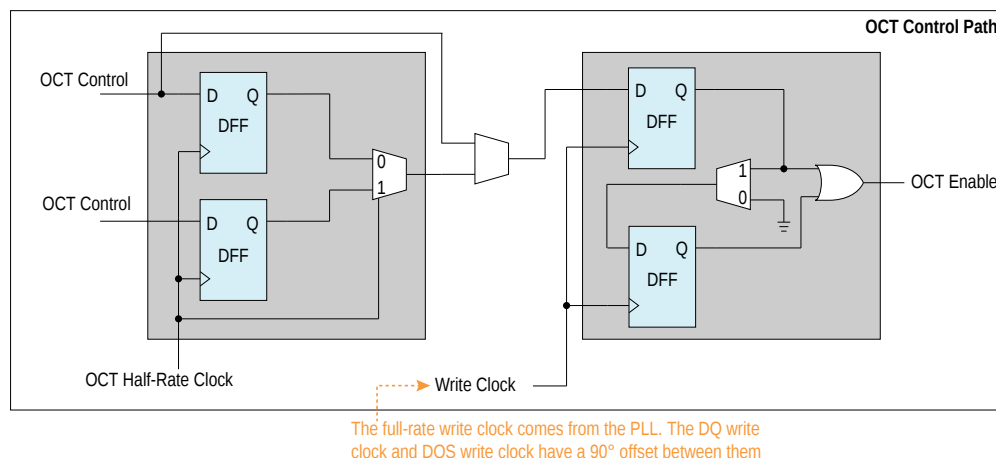
Figure 6-15: Avoiding Glitch on a Non-Consecutive Read Burst Waveform

This figure shows how to avoid postamble glitches using the HDR block.



Dynamic OCT Control

The dynamic OCT control block includes all the registers that are required to dynamically turn the on-chip parallel termination (R_T OCT) on during a read and turn R_T OCT off during a write.

Figure 6-16: Dynamic OCT Control Block for Cyclone V Devices**Related Information**

[Dynamic OCT in Cyclone V Devices](#) on page 5-39

Provides more information about dynamic OCT control.

IOE Registers

The IOE registers are expanded to allow source-synchronous systems to have faster register-to-FIFO transfers and resynchronization. All top, bottom, and right IOEs have the same capability.

Input Registers

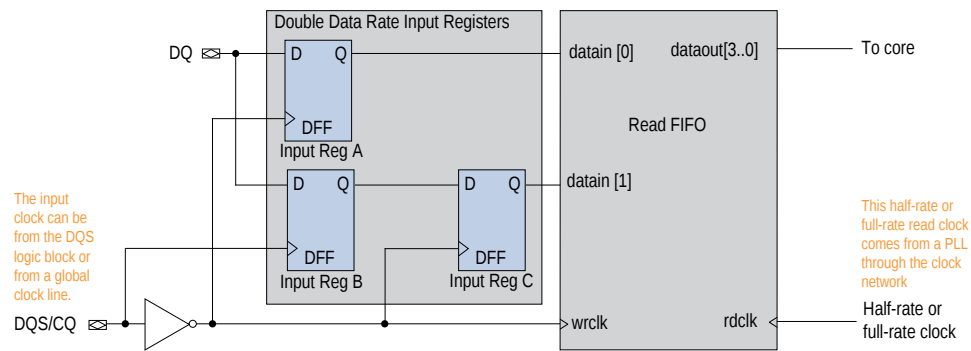
The input path consists of the DDR input registers and the read FIFO block. You can bypass each block of the input path.

There are three registers in the DDR input registers block. Registers A and B capture data on the positive and negative edges of the clock while register C aligns the captured data. Register C uses the same clock as Register A.

The read FIFO block resynchronizes the data to the system clock domain and lowers the data rate to half rate.

The following figure shows the registers available in the Cyclone V input path. For DDR3 and DDR2 SDRAM interfaces, the DQS and DQSn signals must be inverted. If you use Altera's memory interface IPs, the DQS and DQSn signals are automatically inverted.

Figure 6-17: IOE Input Registers for Cyclone V Devices



Output Registers

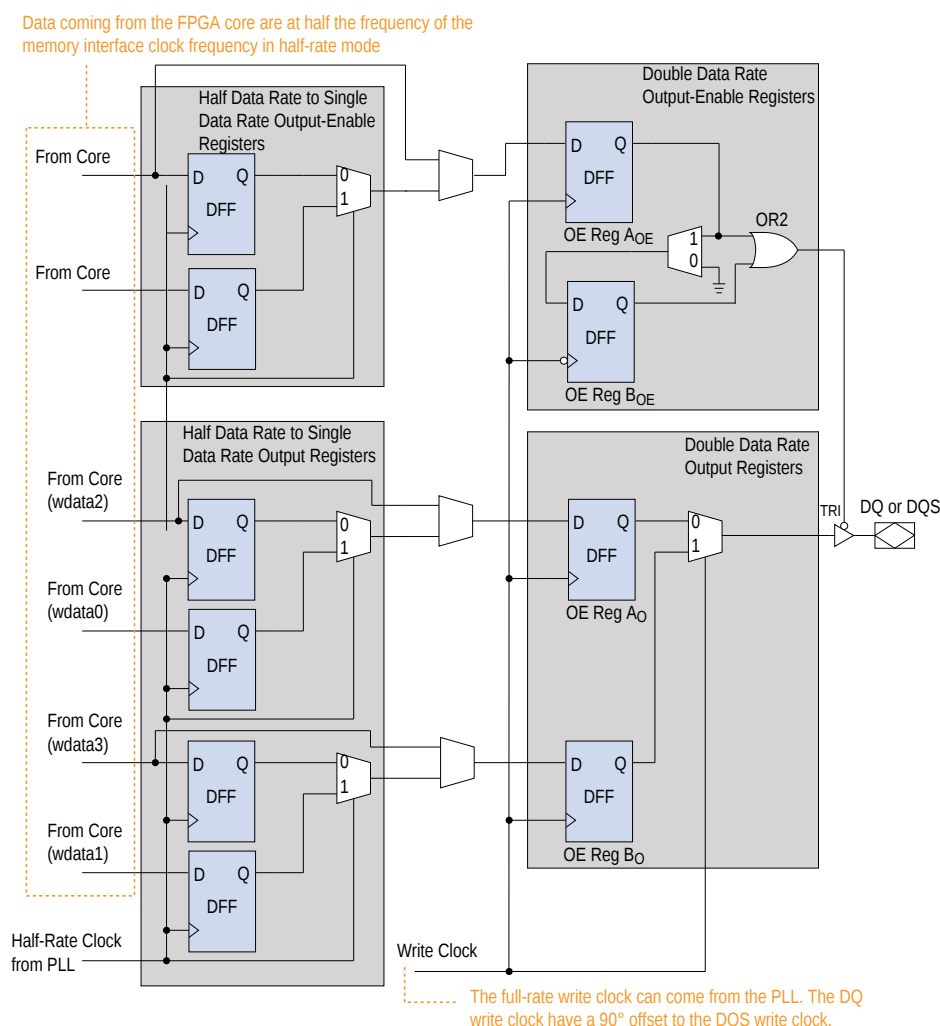
The Cyclone V output and output-enable path is divided into the HDR block, and output and output-enable registers. The device can bypass each block of the output and output-enable path.

The output path is designed to route combinatorial or registered single data rate (SDR) outputs and full-rate or half-rate DDR outputs from the FPGA core. Half-rate data is converted to full-rate with the HDR block, clocked by the half-rate clock from the PLL.

The output-enable path has a structure similar to the output path—ensuring that the output-enable path goes through the same delay and latency as the output path.

Figure 6-18: IOE Output and Output-Enable Path Registers for Cyclone V Devices

The following figure shows the registers available in the Cyclone V output and output-enable paths.



Delay Chains

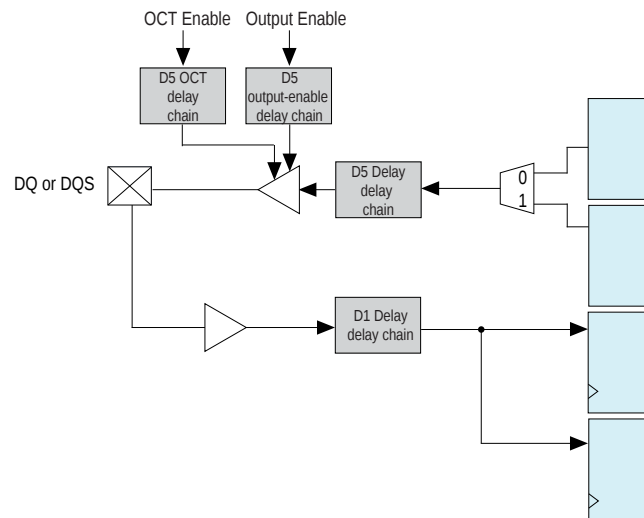
The Cyclone V devices contain run-time adjustable delay chains in the I/O blocks and the DQS logic blocks. You can control the delay chain setting through the I/O or the DQS configuration block output.

Every I/O block contains a delay chain between the following elements:

- The output registers and output buffer
- The input buffer and input register
- The output enable and output buffer
- The R_T OCT enable-control register and output buffer

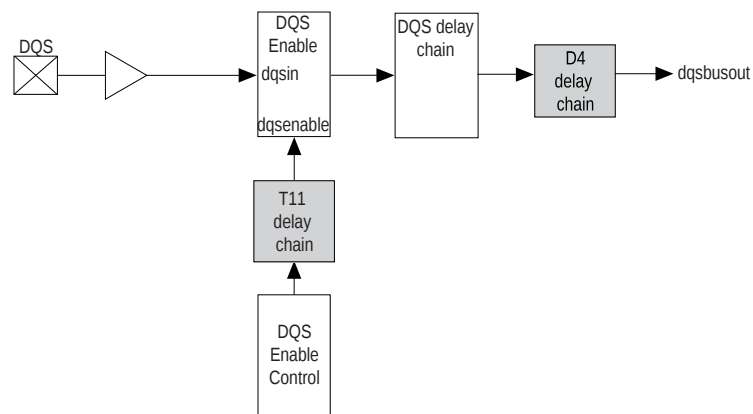
You can bypass the DQS delay chain to achieve a 0° phase shift.

Figure 6-19: Delay Chains in an I/O Block



Each DQS logic block contains a delay chain after the `dqsbussout` output and another delay chain before the `dqsenable` input.

Figure 6-20: Delay Chains in the DQS Input Path



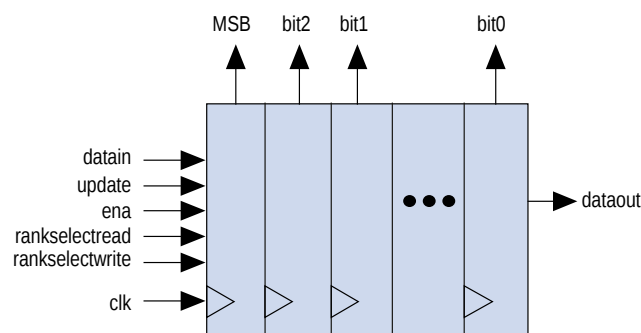
I/O and DQS Configuration Blocks

The I/O and DQS configuration blocks are shift registers that you can use to dynamically change the settings of various device configuration bits.

- The shift registers power-up low.
- Every I/O pin contains one I/O configuration register.
- Every DQS pin contains one DQS configuration block in addition to the I/O configuration register.

Figure 6-21: Configuration Block (I/O and DQS)

This figure shows the I/O configuration block and the DQS configuration block circuitry.

**Related Information****[ALTDQ_DQS2 Megafunction User Guide](#)**

Provides details about the I/O and DQS configuration block bit sequence.

Hard Memory Controller

The Cyclone V devices feature dedicated hard memory controllers. You can use the hard memory controllers for LPDDR2, DDR2, and DDR3 SDRAM interfaces. Compared to the memory controllers implemented using core logic, the hard memory controllers allow support for higher memory interface frequencies with shorter latency cycles.

The hard memory controllers use dedicated I/O pins as data, address, command, control, clock, and ground pins for the SDRAM interface. If you do not use the hard memory controllers, you can use these dedicated pins as regular I/O pins.

Related Information

- **Functional Description—HPC II Controller chapter, External Memory Interface Handbook**
The hard memory controller is functionally similar to the High-Performance Controller II (HPC II).
- **Functional Description—Hard Memory Interface chapter, External Memory Interface Handbook**
Provides detailed information about application of the hard memory interface.

Features of the Hard Memory Controller

Table 6-13: Features of the Cyclone V Hard Memory Controller

Feature	Description
Memory Interface Data Width	<ul style="list-style-type: none"> • 8, 16, and 32 bit data • 16 bit data + 8 bit ECC • 32 bit data + 8bit ECC
Memory Density	The controller supports up to four gigabits density parts and two chip selects.

Feature	Description
Memory Burst Length	<ul style="list-style-type: none"> • DDR3—Burst length of 8 and burst chop of 4 • DDR2—Burst lengths of 4 and 8 • LPDDR2—Burst lengths of 2, 4, 8, and 16
Command and Data Reordering	The controller increases efficiency through the support for out-of-order execution of DRAM commands—with address collision detection-and in-order return of results.
Starvation Control	A starvation counter ensures that all requests are served after a predefined time-out period. This function ensures that data with low priority access are not left behind when reordering data for efficiency.
User-Configurable Priority Support	When the controller detects a high priority request, it allows the request to bypass the current queuing request. This request is processed immediately and thus reduces latency.
Avalon [®] -MM Data Slave Local Interface	By default, the controller supports the Avalon Memory-Mapped protocol.
Bank Management	By default, the controller provides closed-page bank management on every access. The controller intelligently keeps a row open based on incoming traffic. This feature improves the efficiency of the controller especially for random traffic.
Streaming Reads and Writes	The controller can issue reads or writes continuously to sequential addresses every clock cycle if the bank is open. This function allows for very high efficiencies with large amounts of data.
Bank Interleaving	The controller can issue reads or writes continuously to 'random' addresses.
Predictive Bank Management	The controller can issue bank management commands early so that the correct row is open when the read or write occurs. This increases efficiency.
Multiport Interface	The interface allows you to connect up to six data masters to access the memory controller through the local interface. You can update the multiport scheduling configuration without interrupting traffic on a port.
Built-in Burst Adaptor	The controller can accept bursts of arbitrary sizes on its local interface and map these bursts to efficient memory commands.
Run-time Configuration of the Controller	This feature provides support for updates to the timing parameters without requiring reconfiguration of the FPGA, apart from the standard compile-time setting of the timing parameters.
On-Die Termination	The controller controls the on-die termination (ODT) in the memory, which improves signal integrity and simplifies your board design.
User-Controlled Refresh Timing	You can optionally control when refreshes occur—allowing the refreshes to avoid clashing of important reads or writes with the refresh lock-out time.
Low Power Modes	You can optionally request the controller to put the memory into the self-refresh or deep power-down modes.

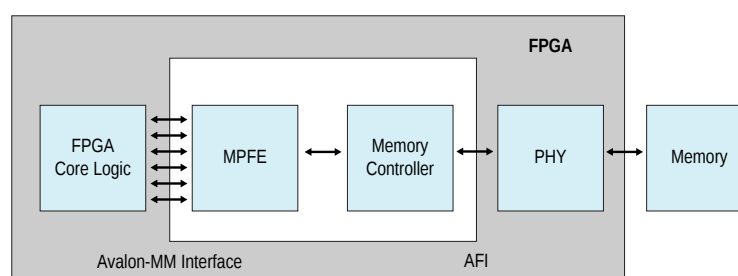
Feature	Description
Partial Array Self-Refresh	You can select the region of memory to refresh during self-refresh through the mode register to save power.
ECC	Standard Hamming single error correction, double error detection (SECDED) error correction code (ECC) support: <ul style="list-style-type: none"> 32 bit data + 8 bit ECC 16 bit data + 8 bit ECC
Additive Latency	With additive latency, the controller can issue a READ/WRITE command after the ACTIVATE command to the bank prior to t_{RCD} to increase the command efficiency.
Write Acknowledgment	The controller supports write acknowledgment on the local interface.
User Control of Memory Controller Initialization	The controller supports initialization of the memory controller under the control of user logic—for example, through the software control in the user system if a processor is present.
Controller Bonding Support	You can bond two controllers to achieve wider data width for higher bandwidth applications.

Multi-Port Front End

The multi-port front end (MPFE) and its associated fabric interface provide up to six command ports, four read-data ports and four write-data ports, through which user logic can access the hard memory controller.

Figure 6-22: Simplified Diagram of the Cyclone V Hard Memory Interface

This figure shows a simplified diagram of the Cyclone V hard memory interface with the MPFE.



Numbers of MPFE Ports Per Device

Table 6-14: Numbers of MPFE Command, Write-Data, and Read-Data Ports for Each Cyclone V Device

Variant	Member Code	MPFE Ports		
		Command	Write-data	Read-data
Cyclone V E	A2	4	2	2
	A4	4	2	2
	A5	6	4	4
	A7	6	4	4
	A9	6	4	4
Cyclone V GX	C3	4	2	2
	C4	6	4	4
	C5	6	4	4
	C7	6	4	4
	C9	6	4	4
Cyclone V GT	D5	6	4	4
	D7	6	4	4
	D9	6	4	4

Bonding Support

You can bond two hard memory controllers to support wider data widths. When you bond two hard memory controllers, the data going out of the controllers to the user logic is synchronized. However, the data going out of the controllers to the memory is not synchronized.

The bonding controllers are not synchronized and remain independent with two separate address buses and two independent command buses. These buses are calibrated separately.

If you require ECC support for a bonded interface, you must implement the ECC logic external to the hard memory controllers.

Note: A memory interface that uses the bonding feature has higher average latency. Bonding through the core fabric will also cause a higher latency.

Figure 6-23: Hard Memory Controllers Bonding Support in Cyclone V E A7, A5, and A9 Devices, Cyclone V GX C4, C5, C7, and C9 Devices, and Cyclone V GT D5, D7, and D9 Devices

This figure shows the bonding of two opposite hard memory controllers through the core fabric. The bottom hard memory controller is not supported in the Cyclone V GX C5 device for the 3.3/3.0 V configuration.

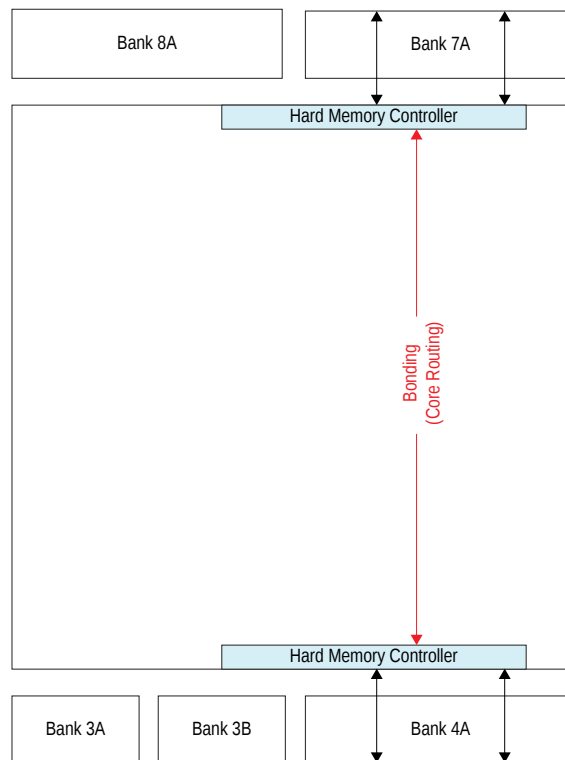
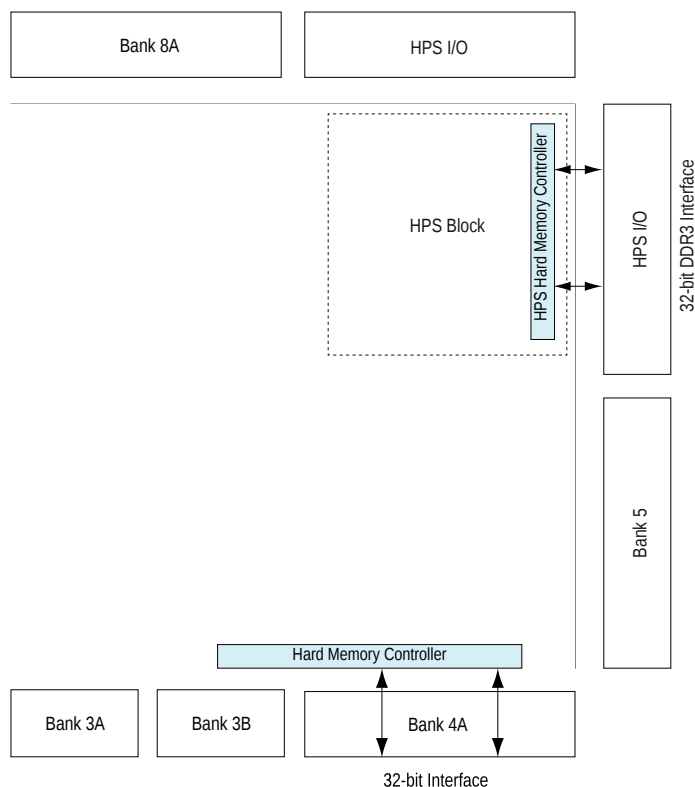


Figure 6-24: Hard Memory Controllers in Cyclone V SX C2, C4, C5, and C6 Devices, and Cyclone V ST D5 and D6 Devices

This figure shows hard memory controllers in the SoC FPGAs. There is no bonding support.

**Related Information****Cyclone V Device Family Pin Connection Guidelines**

Provides more information about the dedicated pins.

Hard Memory Controller Width for Cyclone V E**Table 6-15: Hard Memory Controller Width Per Side in Cyclone V E Devices—Preliminary**

Package	Member Code									
	A2		A4		A5		A7		A9	
	Top	Bottom	Top	Bottom	Top	Bottom	Top	Bottom	Top	Bottom
M383	≤ 24	0	≤ 24	0	≤ 24	0	—	—	—	—
M484	—	—	—	—	—	—	24	24	—	—
F256	0	0	0	0	—	—	—	—	—	—
U324	0	0	0	0	—	—	—	—	—	—
U484	24	0	24	0	24	24	24	24	—	—

Package	Member Code									
	A2		A4		A5		A7		A9	
	Top	Bottom	Top	Bottom	Top	Bottom	Top	Bottom	Top	Bottom
F484	24	0	24	0	40	24	40	24	24	24
F672	—	—	—	—	—	—	40	40	40	40
F896	—	—	—	—	—	—	40	40	40	40

Related Information

Guideline: Using DQ/DQS Pins on page 6-3

Important information about usable pin assignments for the hard memory controller in the F484 package of this device.

Hard Memory Controller Width for Cyclone V GX

Table 6-16: Hard Memory Controller Width Per Side in Cyclone V GX Devices—Preliminary

Package	Member Code									
	C3		C4		C5		C7		C9	
	Top	Bottom	Top	Bottom	Top	Bottom	Top	Bottom	Top	Bottom
M301	—	—	0	0	0	0	—	—	—	—
M383	—	—	≤ 24	0	≤ 24	0	—	—	—	—
M484	—	—	—	—	—	—	24	24	—	—
U324	0	0	—	—	—	—	—	—	—	—
U484	24	0	24	24	24	24	24	24	24	24
F484	24	0	40	24	40	24	40	24	24	24
F672	—	—	40	40	40	40	40	40	40	40
F896	—	—	—	—	—	—	40	40	40	40
F1152	—	—	—	—	—	—	—	—	40	40

Related Information

Guideline: Using DQ/DQS Pins on page 6-3

Important information about usable pin assignments for the hard memory controller in the F484 package of this device.

Hard Memory Controller Width for Cyclone V GT

Table 6-17: Hard Memory Controller Width Per Side in Cyclone V GT Devices—Preliminary

Package	Member Code					
	D5		D7		D9	
	Top	Bottom	Top	Bottom	Top	Bottom
M301	0	0	—	—	—	—
M383	≤ 24	0	—	—	—	—
M484	—	—	24	24	—	—
U484	24	24	24	24	24	24
F484	40	24	40	24	24	24
F672	40	40	40	40	40	40
F896	—	—	40	40	40	40
F1152	—	—	—	—	40	40

Related Information

[Guideline: Using DQ/DQS Pins](#) on page 6-3

Important information about usable pin assignments for the hard memory controller in the F484 package of this device.

Hard Memory Controller Width for Cyclone V SX

Table 6-18: Hard Memory Controller Width Per Side in Cyclone V SX Devices—Preliminary

Package	Member Code							
	C2		C4		C5		C6	
	Top	Bottom	Top	Bottom	Top	Bottom	Top	Bottom
U672	0	40	0	40	0	40	0	40
F896	—	—	—	—	0	40	0	40

Hard Memory Controller Width for Cyclone V ST

Table 6-19: Hard Memory Controller Width Per Side in Cyclone V ST Devices—Preliminary

Package	Member Code			
	D5		D6	
	Top	Bottom	Top	Bottom
F896	0	40	0	40

Document Revision History

Date	Version	Changes
May 2013	2013.05.06	<ul style="list-style-type: none">• Moved all links to the Related Information section of respective topics for easy reference.• Added link to the known document issues in the Knowledge Base.• Added the supported minimum operating frequencies for the supported memory interface standards.• Added packages and updated the DQ/DQS groups of Cyclone V E, GX, GT, and SX devices.• Added the number of MPFE command, write-data, and read-data ports for each Cyclone V E, GX, and GT device.• Added a note about the usable hard memory controller pin assignments for the F484 package of the Cyclone V E A9, GX C9, and GT D9 devices.• Updated the M386 package to M383.• Removed the F672 package from the Cyclone V E A5 device in the table listing Cyclone V E hard memory controller widths.• Added the U484 package for the Cyclone V GX C9 device in the table listing Cyclone V GX hard memory controller widths.• Updated the hard memory controller widths of Cyclone V E, GX, SX, and ST.• Removed the restrictions on using the bottom hard memory controller of the Cyclone V GX C5 device if the configuration is 3.3/3.0 V.• Added note to clarify that the DQS phase-shift circuitry figures show all possible connections and the device pin-out files have per package information.
December 2012	2012.11.28	<ul style="list-style-type: none">• Reorganized content and updated template.• Added a list of supported external memory interface standards using the hard memory controller and soft memory controller.• Added performance information for external memory interfaces and the HPS external memory interfaces.• Separated the DQ/DQS groups tables into separate topics for each device variant for easy reference.• Updated the DQ/DQS numbers and device packages for the Cyclone V E, GX, GT, SX, and ST variants.• Moved the PHYCLK networks pin placement guideline to the Planning Pin and FPGA Resources chapter of the <i>External Memory Interface Handbook</i>.• Moved information from the "Design Considerations" section into relevant topics.• Removed the "DDR2 SDRAM Interface" and "DDR3 SDRAM DIMM" sections. Refer to the relevant sections in the External Memory Interface Handbook for the information.

Date	Version	Changes
		<ul style="list-style-type: none"> Added the I/O and DQS configuration blocks topic. Updated the term "Multiport logic" to "multi-port front end" (MPFE). Added information about the hard memory controller interface widths for the Cyclone V E, GX, GT, SX, and ST variants.
June 2012	2.0	Updated for the Quartus II software v12.0 release: <ul style="list-style-type: none"> Restructured chapter. Updated "Design Considerations", "DQS Postamble Circuitry", and "IOE Registers" sections. Added SoC devices information. Added Figure 6–5, Figure 6–10, and Figure 6–21.
February 2012	1.2	<ul style="list-style-type: none"> Updated Figure 6–20. Minor text edits.
November 2011	1.1	<ul style="list-style-type: none"> Updated Table 6–2. Added Figure 6–2.
October 2011	1.0	Initial release.

Configuration, Design Security, and Remote System Upgrades in Cyclone V Devices

7

2013.06.11

CV-52007



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This chapter describes the configuration schemes, design security, and remote system upgrade that are supported by the Cyclone V devices.

Related Information

- **Cyclone V Device Handbook: Known Issues**
Lists the planned updates to the *Cyclone V Device Handbook* chapters.
- **Cyclone V Device Overview**
Provides more information about configuration features supported for each configuration scheme.
- **Cyclone V Device Datasheet**
Provides more information about the estimated uncompressed **.rbf** file sizes, FPP DCLK-to-DATA [] ratio, and timing parameters.
- **Configuration via Protocol (CvP) Implementation in Altera FPGAs User Guide**
Provides more information about the CvP configuration scheme.
- **Hard Processor System Technical Reference Manual**
Provides more information about configuration via HPS configuration scheme.
- **Design Planning for Partial Reconfiguration**
Provides more information about partial reconfiguration.

Enhanced Configuration and Configuration via Protocol

Cyclone V devices support 1.8 V, 2.5 V, 3.0 V, and 3.3 V programming voltages and several configuration modes.

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Table 7-1: Configuration Modes and Features Supported by Cyclone V Devices

Mode	Data Width	Max Clock Rate (MHz)	Max Data Rate (Mbps)	Decompression	Design Security	Partial Reconfiguration ⁽¹⁴⁾	Remote System Update
AS through the EPCS and EPCQ serial configuration device	1 bit, 4 bits	100	—	Yes	Yes	—	Yes
PS through CPLD or external microcontroller	1 bit	125	125	Yes	Yes	—	—
FPP	8 bits	125	—	Yes	Yes	—	Parallel flash loader
	16 bits	125	—	Yes	Yes	Yes	
CvP (PCIe)	x1, x2, and x4 lanes	—	—	—	Yes	Yes	—
JTAG	1 bit	33	33	—	—	—	—

Instead of using an external flash or ROM, you can configure the Cyclone V devices through PCIe using CvP. The CvP mode offers the fastest configuration rate and flexibility with the easy-to-use PCIe hard IP block interface. The Cyclone V CvP implementation conforms to the PCIe 100 ms power-up-to-active time requirement.

Related Information

[Configuration via Protocol \(CvP\) Implementation in Altera FPGAs User Guide](#)

Provides more information about the CvP configuration scheme.

MSEL Pin Settings

To select a configuration scheme, hardwire the MSEL pins to V_{CCPGM} or GND without pull-up or pull-down resistors.

Note: Do not drive the MSEL pins with a microprocessor or another device.

⁽¹⁴⁾ Partial reconfiguration is an advanced feature of the device family. If you are interested in using partial reconfiguration, contact Altera for support.

Table 7-2: MSEL Pin Settings for Each Configuration Scheme of Cyclone V Devices

Configuration Scheme	Compression Feature	Design Security Feature	V _{CCPGM} (V)	Power-On Reset (POR) Delay	Valid MSEL[4..0]
FPP x8	Disabled	Disabled	1.8/2.5/3.0/3.3	Fast	10100
				Standard	11000
	Disabled	Enabled	1.8/2.5/3.0/3.3	Fast	10101
				Standard	11001
	Enabled	Enabled/ Disabled	1.8/2.5/3.0/3.3	Fast	10110
				Standard	11010
FPP x16	Disabled	Disabled	1.8/2.5/3.0/3.3	Fast	00000
				Standard	00100
	Disabled	Enabled	1.8/2.5/3.0/3.3	Fast	00001
				Standard	00101
	Enabled	Enabled/ Disabled	1.8/2.5/3.0/3.3	Fast	00010
				Standard	00110
PS	Enabled/ Disabled	Enabled/ Disabled	1.8/2.5/3.0/3.3	Fast	10000
				Standard	10001
AS (x1 and x4)	Enabled/ Disabled	Enabled/ Disabled	3.0/3.3	Fast	10010
				Standard	10011
JTAG-based configuration	Disabled	Disabled	—	—	Use any valid MSEL pin settings above

Note: You must also select the configuration scheme in the **Configuration** page of the **Device and Pin Options** dialog box in the Quartus II software. Based on your selection, the option bit in the programming file is set accordingly.

Related Information

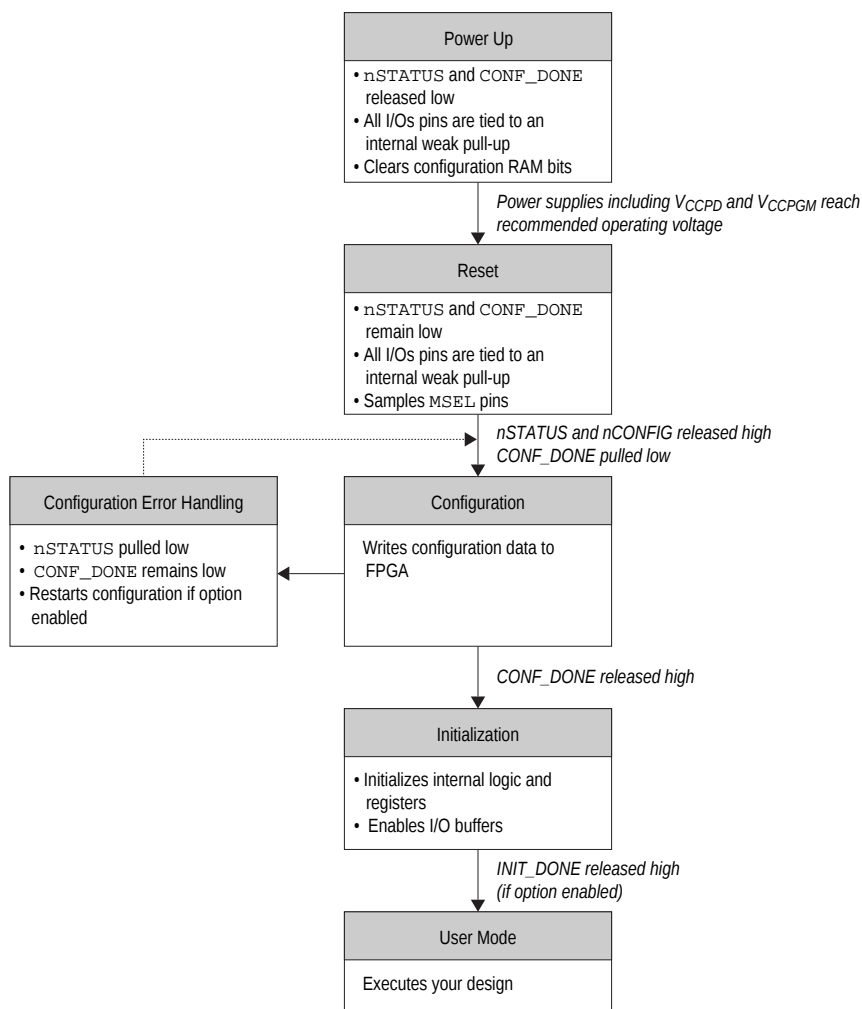
[Cyclone V Device Family Pin Connection Guidelines](#)

Provides more information about JTAG pins voltage-level connection.

Configuration Sequence

Describes the configuration sequence and each configuration stage.

Figure 7-1: Configuration Sequence for Cyclone V Devices



You can initiate reconfiguration by pulling the nCONFIG pin low to at least the minimum t_{CFG} low-pulse width except for configuration using the partial reconfiguration operation. When this pin is pulled low, the nSTATUS and CONF_DONE pins are pulled low and all I/O pins are tied to an internal weak pull-up.

Power Up

Power up all the power supplies that are monitored by the POR circuitry. All power supplies, including VCCPGM and VCCPD, must ramp up from 0 V to the recommended operating voltage level within the ramp-up time specification. Otherwise, hold the nCONFIG pin low until all the power supplies reach the recommended voltage level.

VCCPGM Pin

The configuration input buffers do not have to share power lines with the regular I/O buffers in Cyclone V devices.

The operating voltage for the configuration input pin is independent of the I/O banks power supply, V_{CCIO} , during configuration. Therefore, Cyclone V devices do not require configuration voltage constraints on V_{CCIO} .

V_{CCPD} Pin

Use the V_{CCPD} pin, a dedicated programming power supply, to power the I/O pre-drivers and JTAG I/O pins (TCK, TMS, TDI, and TDO). The supported configuration voltages are 2.5, 3.0, and 3.3 V.

If V_{CCIO} of the bank is set to 2.5 V or lower, V_{CCPD} must be powered up at 2.5 V. If V_{CCIO} is set greater than 2.5 V, V_{CCPD} must be greater than V_{CCIO} . For example, when V_{CCIO} is set to 3.0 V, V_{CCPD} must be set at 3.0 V or above. When V_{CCIO} is set to 3.3 V, V_{CCPD} must be set at 3.3 V.

Related Information

- [Cyclone V Device Datasheet](#)
Provides more information about the ramp-up time specifications.
- [Cyclone V Device Family Pin Connection Guidelines](#)
Provides more information about configuration pin connections.
- [Device Configuration Pins](#) on page 7-6
Provides more information about configuration pins.

Reset

POR delay is the time frame between the time when all the power supplies monitored by the POR circuitry reach the recommended operating voltage and when $nSTATUS$ is released high and the Cyclone V device is ready to begin configuration.

Set the POR delay using the $MSEL$ pins.

The user I/O pins are tied to an internal weak pull-up until the device is configured.

Related Information

- [MSEL Pin Settings](#) on page 7-2
- [Cyclone V Device Datasheet](#)
Provides more information about the POR delay specification.

Configuration

For more information about the $DATA[]$ pins for each configuration scheme, refer to the appropriate configuration scheme.

Configuration Error Handling

To restart configuration automatically, turn on the **Auto-restart configuration after error** option in the **General** page of the **Device and Pin Options** dialog box in the Quartus II software.

If you do not turn on this option, you can monitor the $nSTATUS$ pin to detect errors. To restart configuration, pull the $nCONFIG$ pin low for at least the duration of t_{CFG} .

Related Information**Cyclone V Device Datasheet**

Provides more information about t_{STATUS} and t_{CFG} timing parameters.

Initialization

The initialization clock source is from the internal oscillator, CLKUSR pin, or DCLK pin. By default, the internal oscillator is the clock source for initialization. If you use the internal oscillator, the Cyclone V device will be provided with enough clock cycles for proper initialization.

Note: If you use the optional CLKUSR pin as the initialization clock source and the nCONFIG pin is pulled low to restart configuration during device initialization, ensure that the CLKUSR or DCLK pin continues toggling until the nSTATUS pin goes low and then goes high again.

The CLKUSR pin provides you with the flexibility to synchronize initialization of multiple devices or to delay initialization. Supplying a clock on the CLKUSR pin during initialization does not affect configuration. After the CONF_DONE pin goes high, the CLKUSR or DCLK pin is enabled after the time specified by t_{CD2CU} . When this time period elapses, Cyclone V devices require a minimum number of clock cycles as specified by T_{init} to initialize properly and enter user mode as specified by the t_{CD2UMC} parameter.

Related Information**Cyclone V Device Datasheet**

Provides more information about t_{CD2CU} , t_{init} , and t_{CD2UMC} timing parameters, and initialization clock source.

User Mode

You can enable the optional INIT_DONE pin to monitor the initialization stage. After the INIT_DONE pin is pulled high, initialization completes and your design starts executing. The user I/O pins will then function as specified by your design.

Device Configuration Pins

Configuration Pins Summary

The following table lists the Cyclone V configuration pins and their power supply.

Note: The TDI, TMS, TCK, and TDO pins are powered by V_{CCPD} of the bank in which the pin resides.

Note: The CLKUSR, DEV_OE, DEV_CLRn, and DATA[15 : 5] pins are powered by V_{CCPGM} during configuration and by V_{CCIO} of the bank in which the pin resides if you use it as a user I/O pin.

Table 7-3: Configuration Pin Summary for Cyclone V Devices

Configuration Pin	Configuration Scheme	Input/Output	User Mode	Powered By
TDI	JTAG	Input	—	V_{CCPD}
TMS	JTAG	Input	—	V_{CCPD}

Configuration Pin	Configuration Scheme	Input/Output	User Mode	Powered By
TCK	JTAG	Input	—	V _{CCPD}
TDO	JTAG	Output	—	V _{CCPD}
CLKUSR	All schemes	Input	I/O	V _{CCPGM} /V _{CCIO} ⁽¹⁵⁾
CRC_ERROR	Optional, all schemes	Output	I/O	Pull-up
CONF_DONE	All schemes	Bidirectional	—	V _{CCPGM} /Pull-up
DCLK	FPP and PS	Input	—	V _{CCPGM}
	AS	Output	—	V _{CCPGM}
DEV_OE	Optional, all schemes	Input	I/O	V _{CCPGM} /V _{CCIO} ⁽¹⁵⁾
DEV_CLRn	Optional, all schemes	Input	I/O	V _{CCPGM} /V _{CCIO} ⁽¹⁵⁾
INIT_DONE	Optional, all schemes	Output	I/O	Pull-up
MSEL[4..0]	All schemes	Input	—	V _{CCPGM}
nSTATUS	All schemes	Bidirectional	—	V _{CCPGM} /Pull-up
nCE	All schemes	Input	—	V _{CCPGM}
nCEO	All schemes	Output	I/O	Pull-up
nCONFIG	All schemes	Input	—	V _{CCPGM}
DATA[15..5]	FPP x8 and x16	Input	I/O	V _{CCPGM} /V _{CCIO} ⁽¹⁵⁾
nCSO/DATA4	AS	Output	—	V _{CCPGM}
	FPP	Input	—	V _{CCPGM}
AS_DATA[3..1]/DATA[3..1]	AS	Bidirectional	—	V _{CCPGM}
	FPP	Input	—	V _{CCPGM}
AS_DATA0/DATA0/ ASDO	AS	Bidirectional	—	V _{CCPGM}
	FPP and PS	Input	—	V _{CCPGM}
PR_REQUEST	FPP x16	Input	I/O	V _{CCPGM} /V _{CCIO} ⁽¹⁵⁾

⁽¹⁵⁾ This pin is powered by V_{CCPGM} before user mode and powered by V_{CCIO} during user mode.

Configuration Pin	Configuration Scheme	Input/Output	User Mode	Powered By
PR_READY	FPP x16	Output	I/O	$V_{CCPGM}/V_{CCIO}^{(15)}$
PR_ERROR	FPP x16	Output	I/O	$V_{CCPGM}/V_{CCIO}^{(15)}$
PR_DONE	FPP x16	Output	I/O	$V_{CCPGM}/V_{CCIO}^{(15)}$

Related Information**Cyclone V Device Family Pin Connection Guidelines**

Provides more information about each configuration pin.

Configuration Pin Options in the Quartus II Software

The following table lists the dual-purpose configuration pins available in the **Device and Pin Options** dialog box in the Quartus II software.

Table 7-4: Configuration Pin Options

Configuration Pin	Category Page	Option
CLKUSR	General	Enable user-supplied start-up clock (CLKUSR)
DEV_CLRn	General	Enable device-wide reset (DEV_CLRn)
DEV_OE	General	Enable device-wide output enable (DEV_OE)
INIT_DONE	General	Enable INIT_DONE output
nCEO	General	Enable nCEO pin
CRC_ERROR	Error Detection CRC	Enable Error Detection CRC_ERROR pin
		Enable open drain on CRC_ERROR pin
		Enable internal scrubbing
PR_REQUEST	General	Enable PR pin
PR_READY		
PR_ERROR		
PR_DONE		

Related Information**Reviewing Printed Circuit Board Schematics with the Quartus II Software**

Provides more information about the device and pin options dialog box setting.

Fast Passive Parallel Configuration

The FPP configuration scheme uses an external host, such as a microprocessor, MAX[®] II device, or MAX V device. This scheme is the fastest method to configure Cyclone V devices. The FPP configuration scheme supports 8- and 16-bits data width.

You can use an external host to control the transfer of configuration data from an external storage such as flash memory to the FPGA. The design that controls the configuration process resides in the external host. You can store the configuration data in Raw Binary File (.rbf), Hexadecimal (Intel-Format) File (.hex), or Tabular Text File (.tff) formats.

You can use the PFL megafunction with a MAX II or MAX V device to read configuration data from the flash memory device and configure the Cyclone V device.

Note: Two DCLK falling edges are required after the CONF_DONE pin goes high to begin the initialization of the device for both uncompressed and compressed configuration data in an FPP configuration.

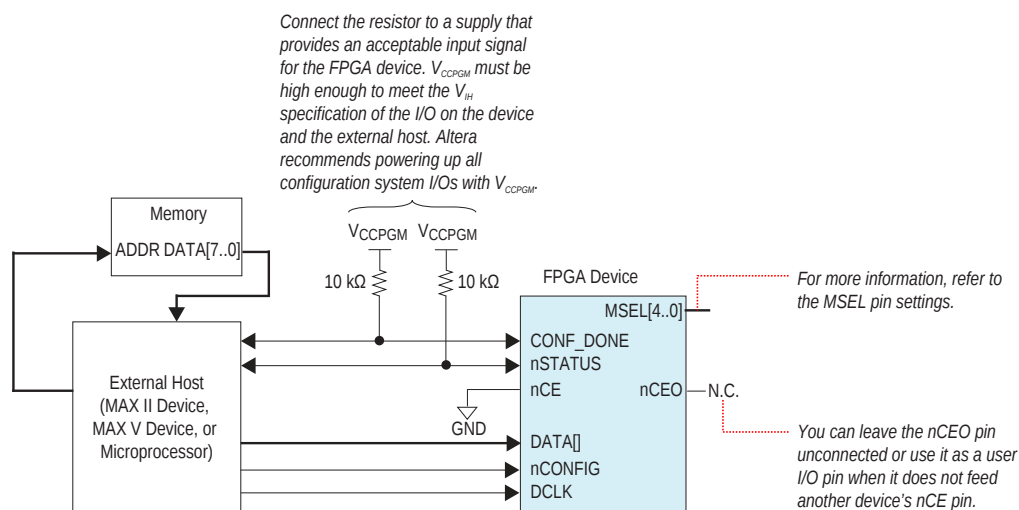
Related Information

- [Parallel Flash Loader Megafunction User Guide](#)
- [Cyclone V Device Datasheet](#)
Provides more information about the FPP configuration timing.

Fast Passive Parallel Single-Device Configuration

To configure a Cyclone V device, connect the device to an external host as shown in the following figure.

Figure 7-2: Single Device FPP Configuration Using an External Host



Fast Passive Parallel Multi-Device Configuration

You can configure multiple Cyclone V devices that are connected in a chain.

Pin Connections and Guidelines

Observe the following pin connections and guidelines for this configuration setup:

- Tie the following pins of all devices in the chain together:
 - nCONFIG
 - nSTATUS
 - DCLK
 - DATA[]
 - CONF_DONE

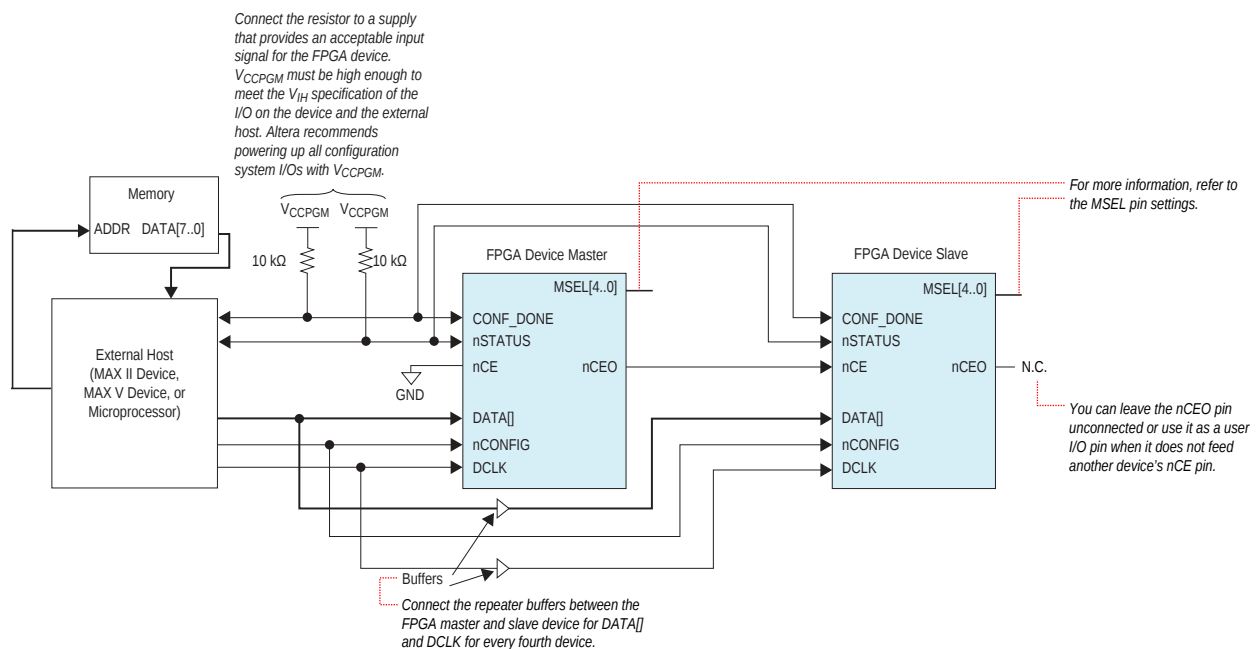
By tying the CONF_DONE and nSTATUS pins together, the devices initialize and enter user mode at the same time. If any device in the chain detects an error, configuration stops for the entire chain and you must reconfigure all the devices. For example, if the first device in the chain flags an error on the nSTATUS pin, it resets the chain by pulling its nSTATUS pin low.

- Ensure that DCLK and DATA[] are buffered for every fourth device to prevent signal integrity and clock skew problems.
- All devices in the chain must use the same data width.
- If you are configuring the devices in the chain using the same configuration data, the devices must be of the same package and density.

Using Multiple Configuration Data

To configure multiple Cyclone V devices in a chain using multiple configuration data, connect the devices to an external host as shown in the following figure.

Figure 7-3: Multiple Device FPP Configuration Using an External Host When Both Devices Receive a Different Set of Configuration Data



When a device completes configuration, its nCEO pin is released low to activate the nCE pin of the next device in the chain. Configuration automatically begins for the second device in one clock cycle.

Using One Configuration Data

To configure multiple Cyclone V devices in a chain using one configuration data, connect the devices to an external host as shown in the following figure.

Figure 7-4: Multiple Device FPP Configuration Using an External Host When Both Devices Receive the Same Data

The maximum DCLK frequency supported by the AS configuration scheme is 100 MHz except for the AS multi-device configuration scheme. You can source DCLK using CLKUSR or the internal oscillator. If you use the internal oscillator, you can choose a 12.5, 25, 50, or 100 MHz clock under the **Device and Pin Options** dialog box, in the **Configuration** page of the Quartus II software.

After power-up, DCLK is driven by a 12.5 MHz internal oscillator by default. The Cyclone V device determines the clock source and frequency to use by reading the option bit in the programming file.

Related Information

Cyclone V Device Datasheet

Provides more information about the DCLK frequency specification in the AS configuration scheme.

Active Serial Single-Device Configuration

To configure a Cyclone V device, connect the device to a serial configuration (EPCS) device or quad-serial configuration (EPCQ) device, as shown in the following figures.

Figure 7-5: Single Device AS x1 Mode Configuration

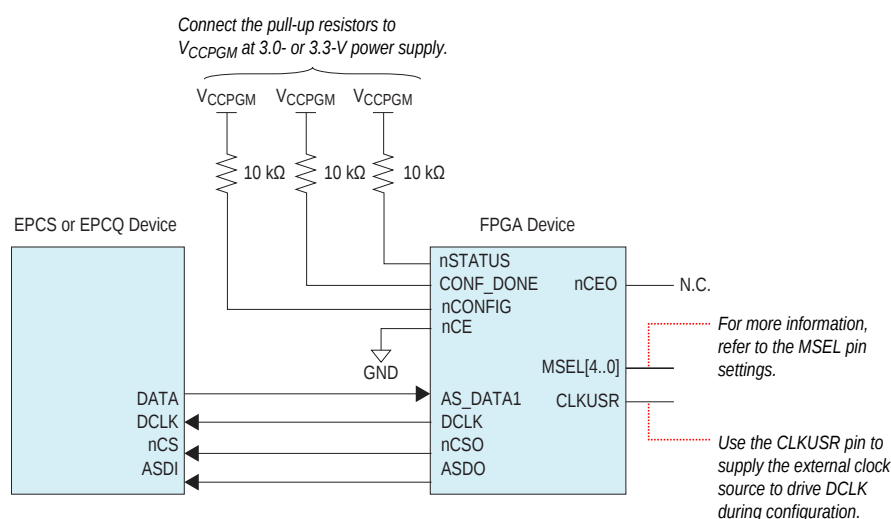
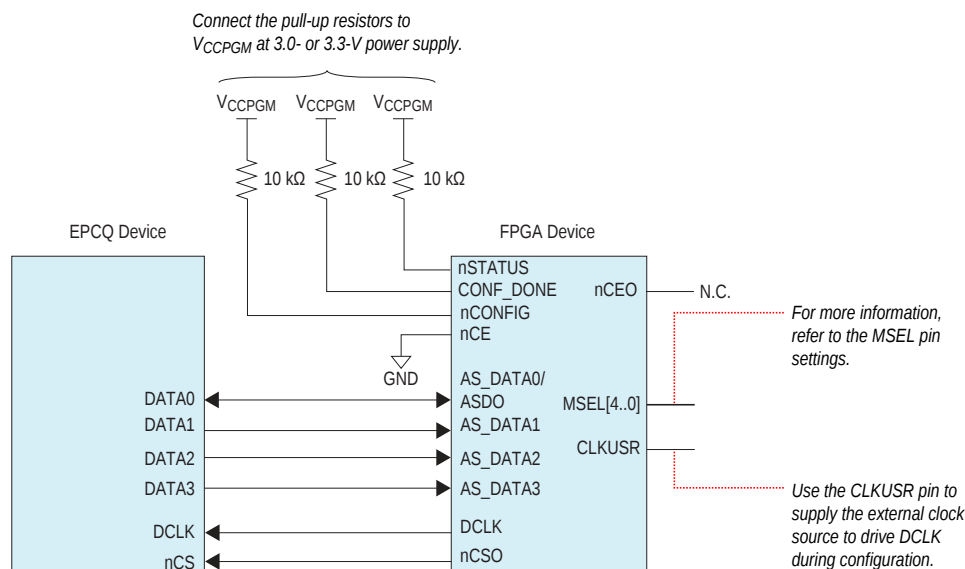


Figure 7-6: Single Device AS x4 Mode Configuration

Active Serial Multi-Device Configuration

You can configure multiple Cyclone V devices that are connected to a chain. Only AS x1 mode supports multi-device configuration.

The first device in the chain is the configuration master. Subsequent devices in the chain are configuration slaves.

Pin Connections and Guidelines

Observe the following pin connections and guidelines for this configuration setup:

- Hardwire the MSEL pins of the first device in the chain to select the AS configuration scheme. For subsequent devices in the chain, hardwire their MSEL pins to select the PS configuration scheme. Any other Altera® devices that support the PS configuration can also be part of the chain as a configuration slave.
- Tie the following pins of all devices in the chain together:
 - nCONFIG
 - nSTATUS
 - DCLK
 - DATA[]
 - CONF_DONE

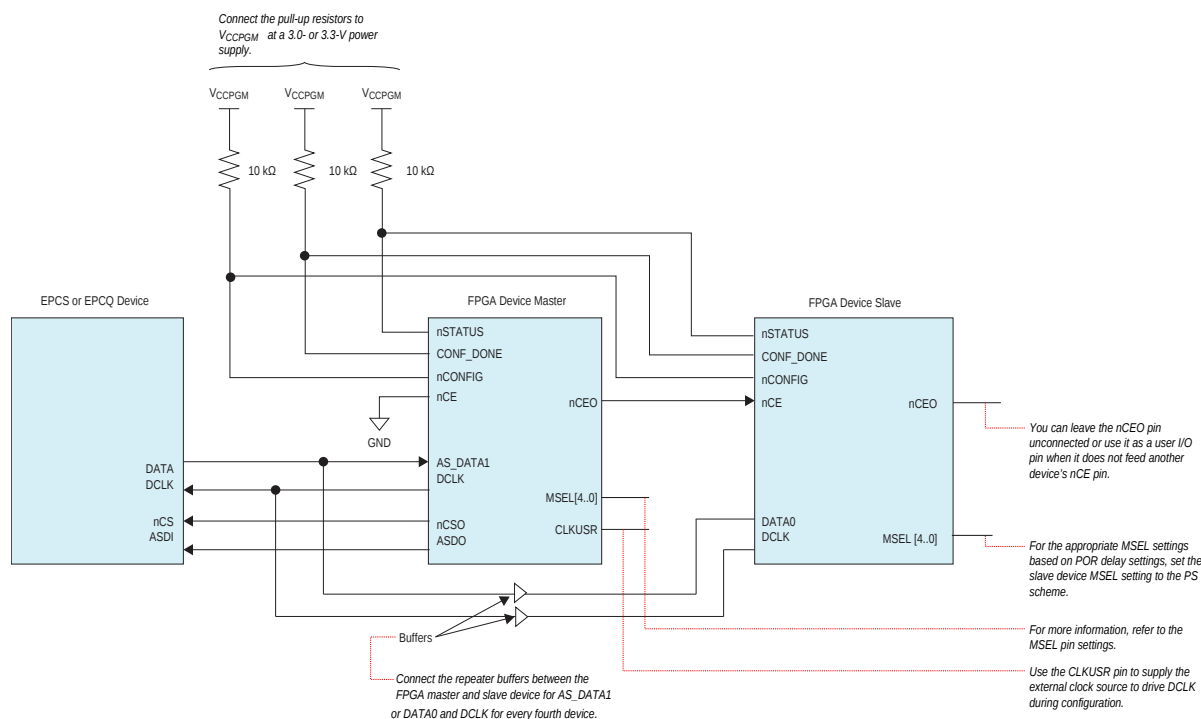
By tying the CONF_DONE, nSTATUS, and nCONFIG pins together, the devices initialize and enter user mode at the same time. If any device in the chain detects an error, configuration stops for the entire chain and you must reconfigure all the devices. For example, if the first device in the chain flags an error on the nSTATUS pin, it resets the chain by pulling its nSTATUS pin low.

- Ensure that DCLK and DATA[] are buffered every fourth device to prevent signal integrity and clock skew problems.

Using Multiple Configuration Data

To configure multiple Cyclone V devices in a chain using multiple configuration data, connect the devices to an EPCS or EPCQ device, as shown in the following figure.

Figure 7-7: Multiple Device AS Configuration When Both Devices in the Chain Receive Different Sets of Configuration Data



When a device completes configuration, its nCEO pin is released low to activate the nCE pin of the next device in the chain. Configuration automatically begins for the second device in one clock cycle.

Estimating the Active Serial Configuration Time

The AS configuration time is mostly the time it takes to transfer the configuration data from an EPCS or EPCQ device to the Cyclone V device.

Use the following equations to estimate the configuration time:

- AS x1 mode

$$\text{.rbf Size} \times (\text{minimum DCLK period} / 1 \text{ bit per DCLK cycle}) = \text{estimated minimum configuration time.}$$
- AS x4 mode

$$\text{.rbf Size} \times (\text{minimum DCLK period} / 4 \text{ bits per DCLK cycle}) = \text{estimated minimum configuration time.}$$

Compressing the configuration data reduces the configuration time. The amount of reduction varies depending on your design.

Using EPCS and EPCQ Devices

EPCS devices support AS x1 mode and EPCQ devices support AS x1 and AS x4 modes.

Related Information

- [Serial Configuration \(EPCS\) Devices Datasheet](#)
- [Quad-Serial Configuration \(EPCQ\) Devices Datasheet](#)

Controlling EPCS and EPCQ Devices

During configuration, Cyclone V devices enable the EPCS or EPCQ device by driving its nCSO output pin low, which connects to the chip select (nCS) pin of the EPCS or EPCQ device. Cyclone V devices use the DCLK and ASDO pins to send operation commands and read address signals to the EPCS or EPCQ device. The EPCS or EPCQ device provides data on its serial data output (DATA[]) pin, which connects to the AS_DATA[] input of the Cyclone V devices.

Note: If you wish to gain control of the EPCS pins, hold the nCONFIG pin low and pull the nCE pin high. This causes the device to reset and tri-state the AS configuration pins.

Trace Length and Loading

The maximum trace length and loading apply to both single- and multi-device AS configuration setups as listed in the following table. The trace length is the length from the Cyclone V device to the EPCS or EPCQ device.

Table 7-5: Maximum Trace Length and Loading for AS x1 and x4 Configurations for Cyclone V Devices

Cyclone V Device AS Pins	Maximum Board Trace Length (Inches)		Maximum Board Load (pF)
	12.5/ 25/ 50 MHz	100 MHz	
DCLK	10	6	5
DATA[3 . . 0]	10	6	10
nCSO	10	6	10

Programming EPCS and EPCQ Devices

You can program EPCS and EPCQ devices in-system using a USB-Blaster™, EthernetBlaster, EthernetBlaster II, or ByteBlaster™ II download cable. Alternatively, you can program the EPCS or EPCQ using a microprocessor with the SRunner software driver.

In-system programming (ISP) offers you the option to program the EPCS or EPCQ either using an AS programming interface or a JTAG interface. Using the AS programming interface, the configuration data is programmed into the EPCS by the Quartus II software or any supported third-party software. Using the JTAG interface, an Altera IP called the serial flash loader (SFL) must be downloaded into the Cyclone V device to form a bridge between the JTAG interface and the EPCS or EPCQ. This allows the EPCS or EPCQ to be programmed directly using the JTAG interface.

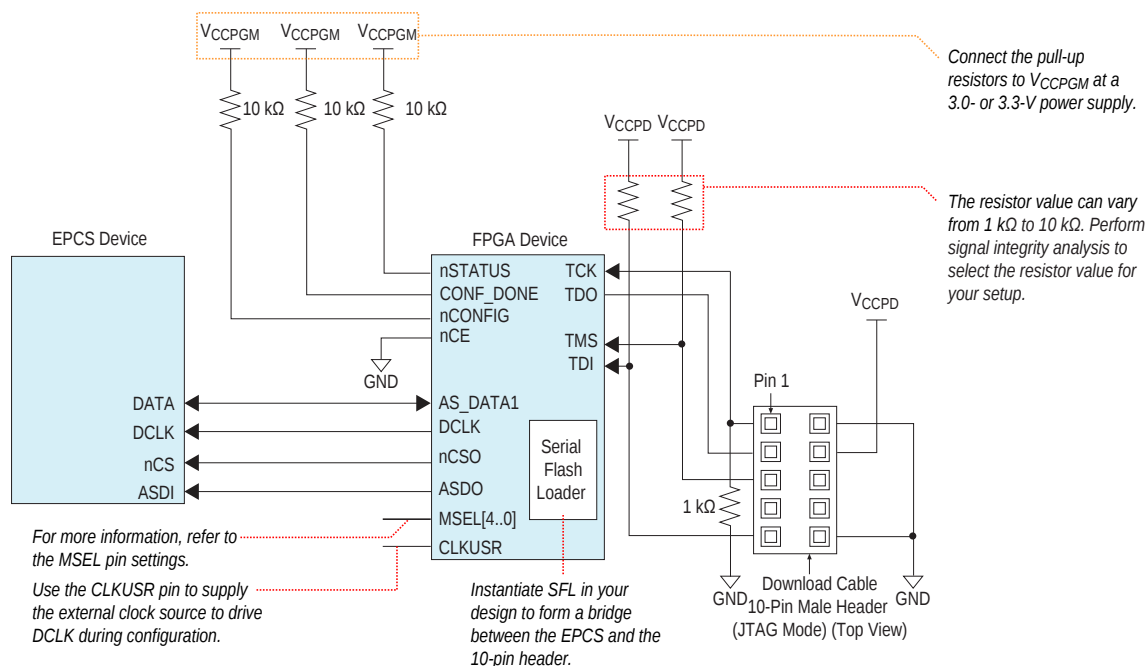
Related Information

- [AN 370: Using the Serial FlashLoader with the Quartus II Software](#)
- [AN 418: SRunner: An Embedded Solution for Serial Configuration Device Programming](#)

Programming EPCS Using the JTAG Interface

To program an EPCS device using the JTAG interface, connect the device as shown in the following figure.

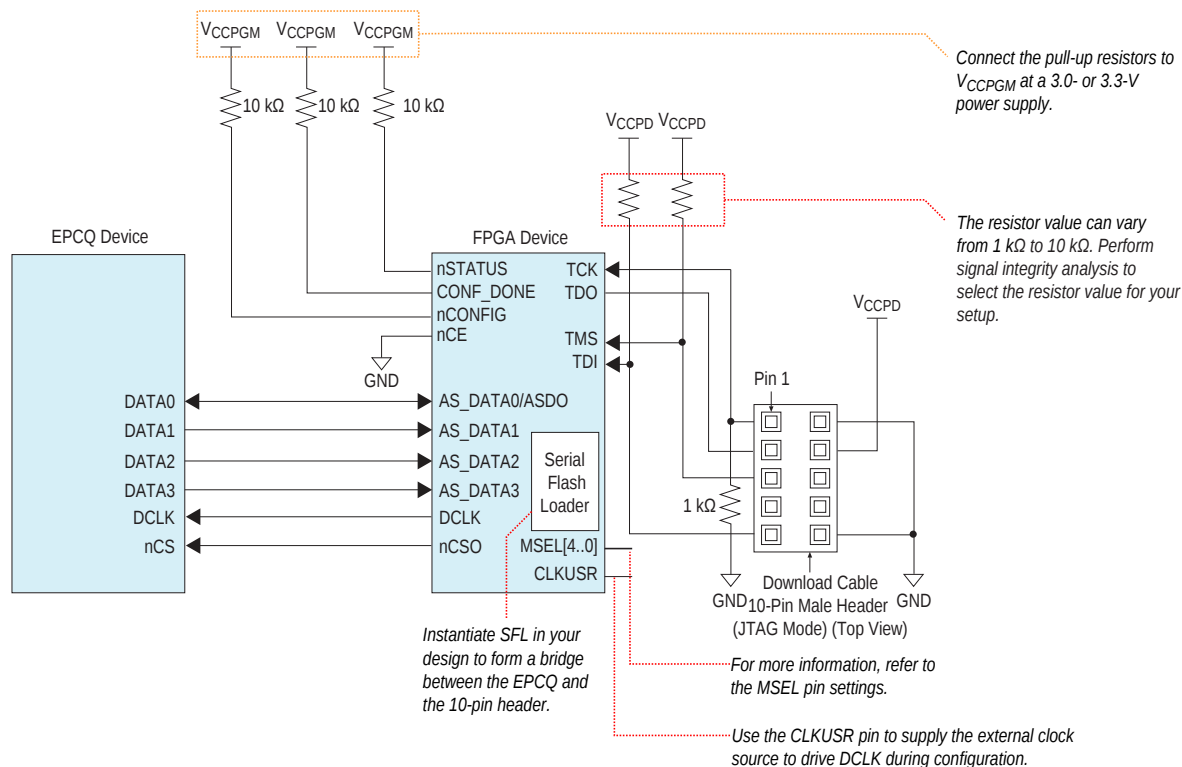
Figure 7-8: Connection Setup for Programming the EPCS Using the JTAG Interface



Programming EPCQ Using the JTAG Interface

To program an EPCQ device using the JTAG interface, connect the device as shown in the following figure.

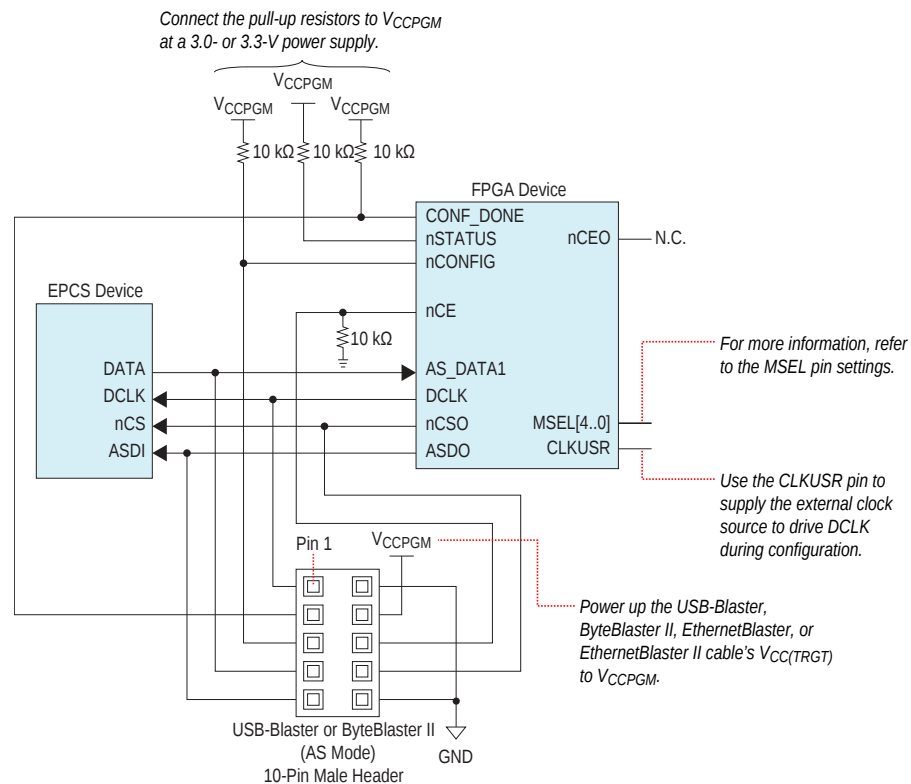
Figure 7-9: Connection Setup for Programming the EPCQ Using the JTAG Interface



Programming EPCS Using the Active Serial Interface

To program an EPCS device using the AS interface, connect the device as shown in the following figure.

Figure 7-10: Connection Setup for Programming the EPCS Using the AS Interface

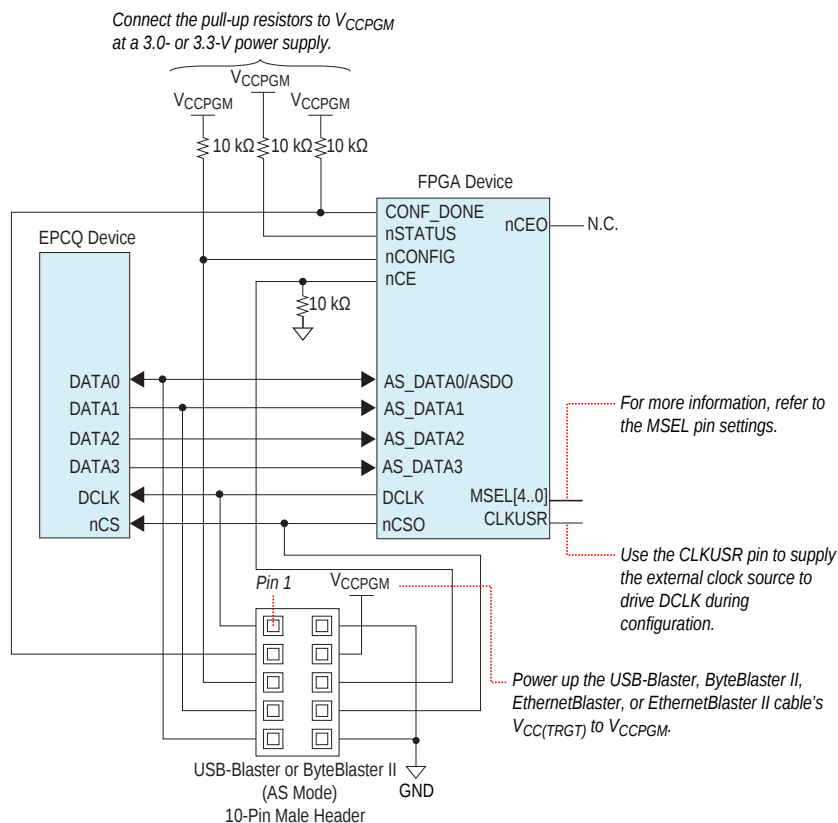


Programming EPCQ Using the Active Serial Interface

To program an EPCQ device using the AS interface, connect the device as shown in the following figure.

Figure 7-11: Connection Setup for Programming the EPCQ Using the AS Interface

Using the AS header, the programmer serially transmits the operation commands and configuration bits to the EPCQ on DATA0. This is equivalent to the programming operation for the EPCS.



When programming the EPCS and EPCQ devices, the download cable disables access to the AS interface by driving the nCE pin high. The nCONFIG line is also pulled low to hold the Cyclone V device in the reset stage. After programming completes, the download cable releases nCE and nCONFIG, allowing the pull-down and pull-up resistors to drive the pin to GND and V_{CCPGM}, respectively.

During the EPCQ programming using the download cable, DATA0 transfers the programming data, operation command, and address information from the download cable into the EPCQ. During the EPCQ verification using the download cable, DATA1 transfers the programming data back to the download cable.

Passive Serial Configuration

The PS configuration scheme uses an external host. You can use a microprocessor, MAX II device, MAX V device, or a host PC as the external host.

You can use an external host to control the transfer of configuration data from an external storage such as flash memory to the FPGA. The design that controls the configuration process resides in the external host.

You can store the configuration data in Programmer Object File (.pof), .rbf, .hex, or .ttf. If you are using configuration data in .rbf, .hex, or .ttf, send the LSB of each data byte first. For example, if the .rbf contains

the byte sequence 02 1B EE 01 FA, the serial data transmitted to the device must be 0100-0000 1101-1000 0111-0111 1000-0000 0101-1111.

You can use the PFL megafunction with a MAX II or MAX V device to read configuration data from the flash memory device and configure the Cyclone V device.

For a PC host, connect the PC to the device using a download cable such as the Altera USB-Blaster USB port, ByteBlaster II parallel port, EthernetBlaster, and EthernetBlaster II download cables.

The configuration data is shifted serially into the DATA0 pin of the device.

If you are using the Quartus II programmer and the CLKUSR pin is enabled, you do not need to provide a clock source for the pin to initialize your device.

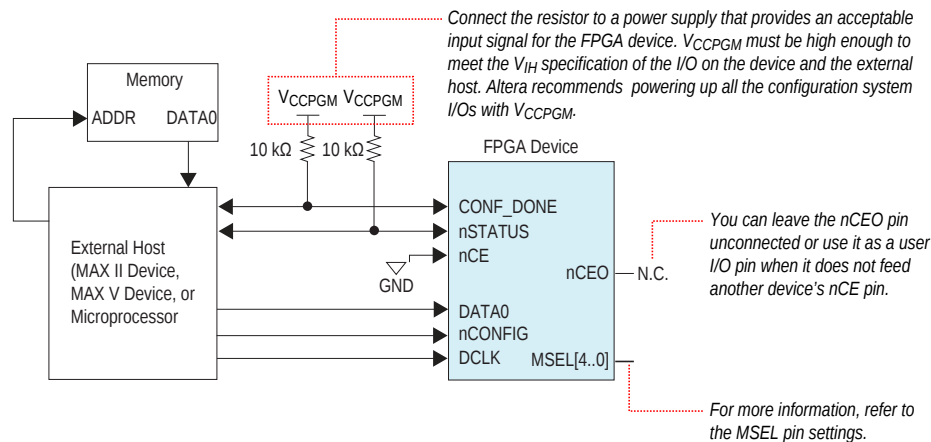
Related Information

- [Parallel Flash Loader Megafunction User Guide](#)
- [Cyclone V Device Datasheet](#)
Provides more information about the PS configuration timing.

Passive Serial Single-Device Configuration Using an External Host

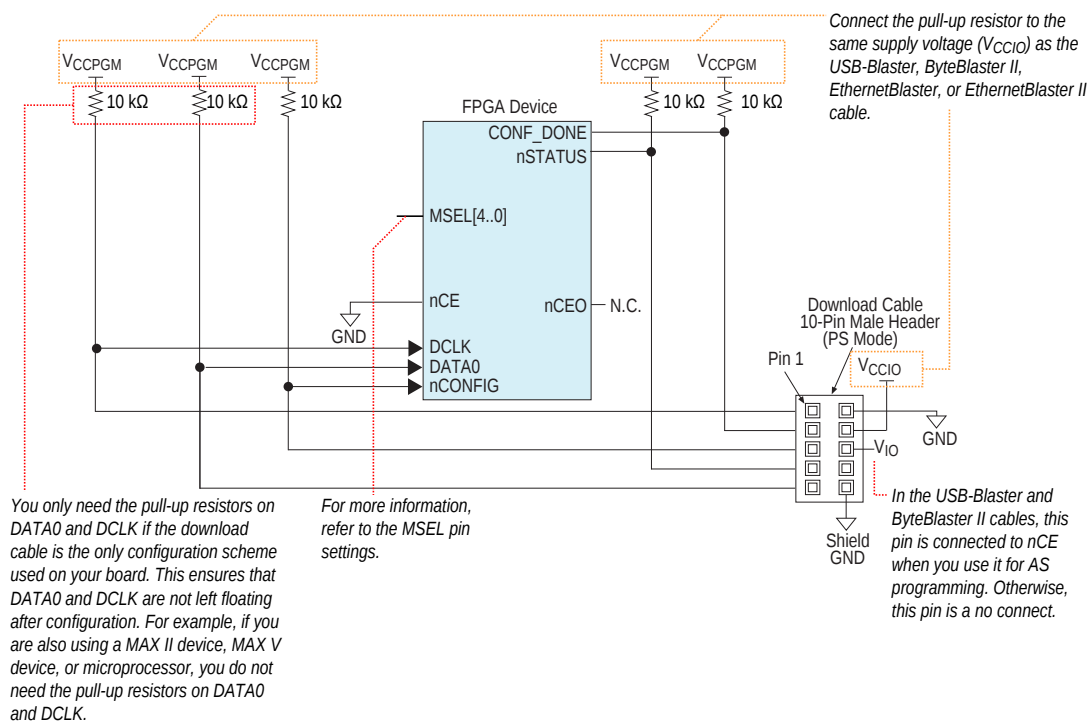
To configure a Cyclone V device, connect the device to an external host, as shown in the following figure.

Figure 7-12: Single Device PS Configuration Using an External Host



Passive Serial Single-Device Configuration Using an Altera Download Cable

To configure a Cyclone V device, connect the device to a download cable, as shown in the following figure.

Figure 7-13: Single Device PS Configuration Using an Altera Download Cable

Passive Serial Multi-Device Configuration

You can configure multiple Cyclone V devices that are connected in a chain.

Pin Connections and Guidelines

Observe the following pin connections and guidelines for this configuration setup:

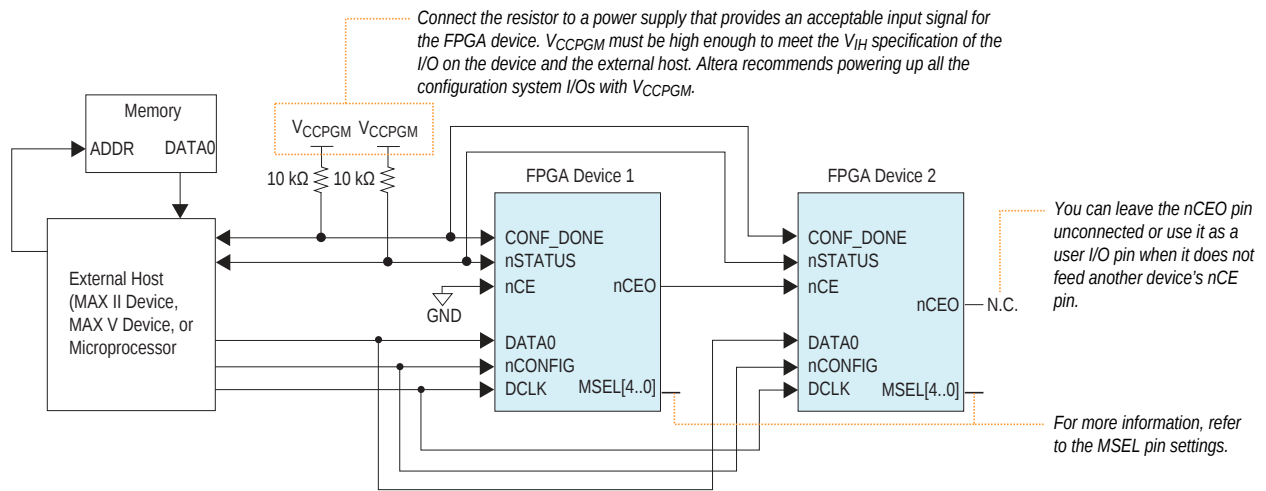
- Tie the following pins of all devices in the chain together:
 - nCONFIG
 - nSTATUS
 - DCLK
 - DATA0
 - CONF_DONE

By tying the CONF_DONE and nSTATUS pins together, the devices initialize and enter user mode at the same time. If any device in the chain detects an error, configuration stops for the entire chain and you must reconfigure all the devices. For example, if the first device in the chain flags an error on the nSTATUS pin, it resets the chain by pulling its nSTATUS pin low.

- If you are configuring the devices in the chain using the same configuration data, the devices must be of the same package and density.

Using Multiple Configuration Data

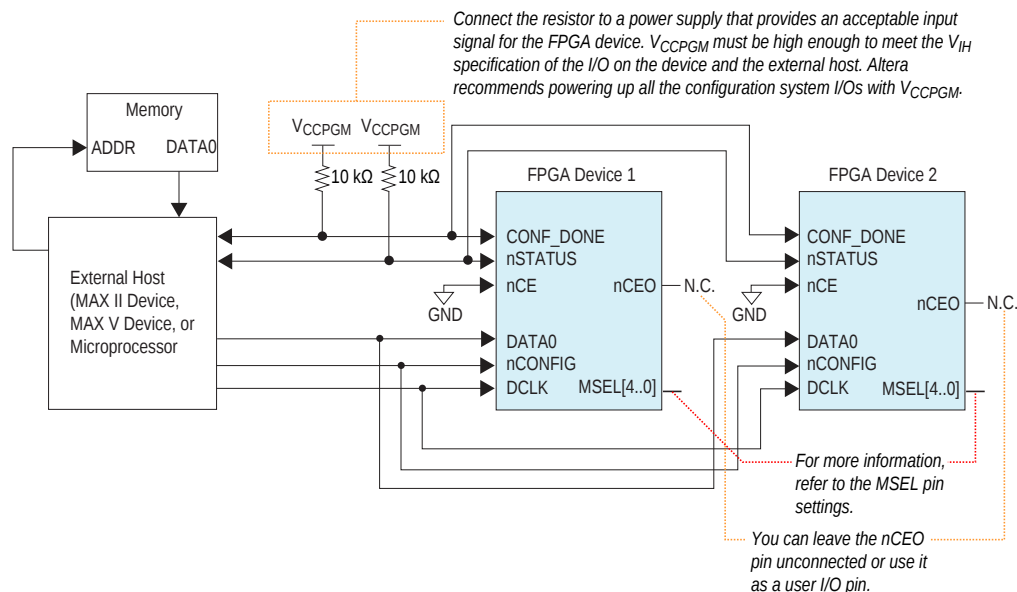
To configure multiple Cyclone V devices in a chain using multiple configuration data, connect the devices to the external host as shown in the following figure.

Figure 7-14: Multiple Device PS Configuration when Both Devices Receive Different Sets of Configuration Data

After a device completes configuration, its nCEO pin is released low to activate the nCE pin of the next device in the chain. Configuration automatically begins for the second device in one clock cycle.

Using One Configuration Data

To configure multiple Cyclone V devices in a chain using one configuration data, connect the devices to an external host, as shown in the following figure.

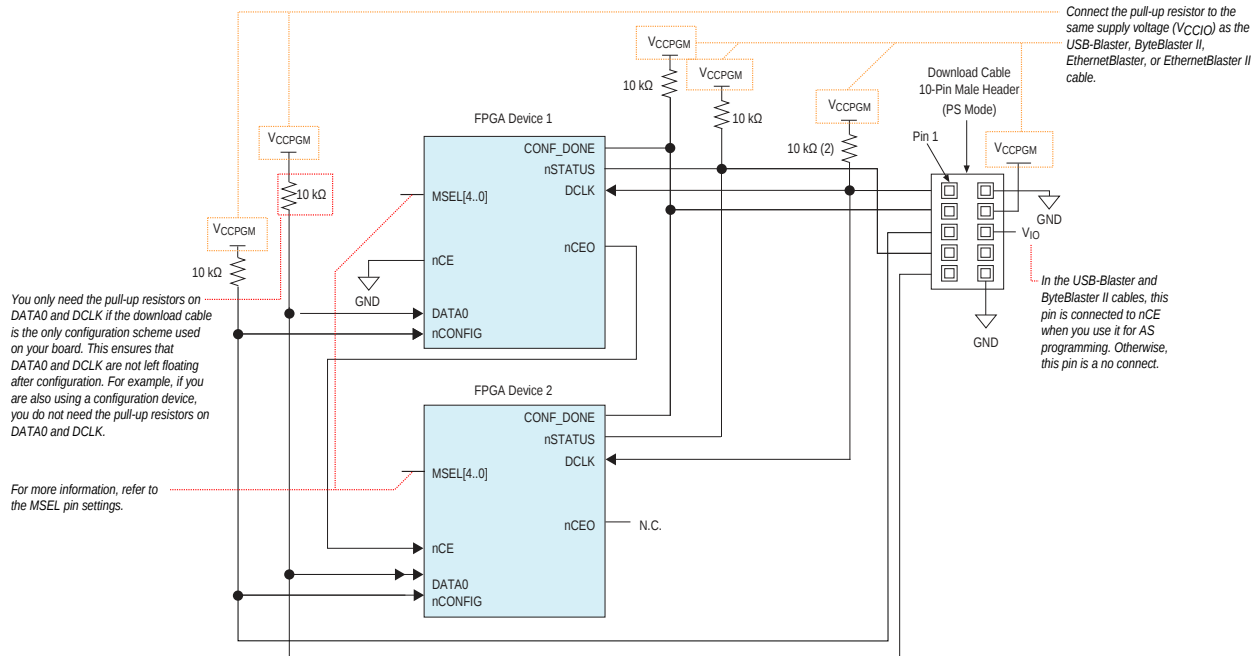
Figure 7-15: Multiple Device PS Configuration When Both Devices Receive the Same Set of Configuration Data

The nCE pins of the devices in the chain are connected to GND, allowing configuration for these devices to begin and end at the same time.

Using PC Host and Download Cable

To configure multiple Cyclone V devices, connect the devices to a download cable, as shown in the following figure.

Figure 7-16: Multiple Device PS Configuration Using an Altera Download Cable



When a device completes configuration, its nCEO pin is released low to activate the nCE pin of the next device. Configuration automatically begins for the second device.

JTAG Configuration

In Cyclone V devices, JTAG instructions take precedence over other configuration schemes.

The Quartus II software generates an SRAM Object File (.sof) that you can use for JTAG configuration using a download cable in the Quartus II software programmer. Alternatively, you can use the JRunner software with .rbf or a JAM™ Standard Test and Programming Language (STAPL) Format File (.jam) or JAM Byte Code File (.jbc) with other third-party programmer tools.

Related Information

- [JTAG Boundary-Scan Testing in Cyclone V Devices](#) on page 9-1
Provides more information about JTAG boundary-scan testing.
- [Device Configuration Pins](#) on page 7-6
Provides more information about JTAG configuration pins.

- [JTAG Secure Mode](#) on page 7-34
- [AN 425: Using the Command-Line Jam STAPL Solution for Device Programming](#)
- [Cyclone V Device Datasheet](#)
Provides more information about the JTAG configuration timing.
- [JTAG Boundary-Scan Testing in Cyclone V Devices](#)
- [Programming Support for Jam STAPL Language](#)
- [USB-Blaster Download Cable User Guide](#)
- [ByteBlaster II Download Cable User Guide](#)
- [EthernetBlaster Communications Cable User Guide](#)
- [EthernetBlaster II Communications Cable User Guide](#)

JTAG Single-Device Configuration

To configure a single device in a JTAG chain, the programming software sets the other devices to the bypass mode. A device in a bypass mode transfers the programming data from the TDI pin to the TDO pin through a single bypass register. The configuration data is available on the TDO pin one clock cycle later.

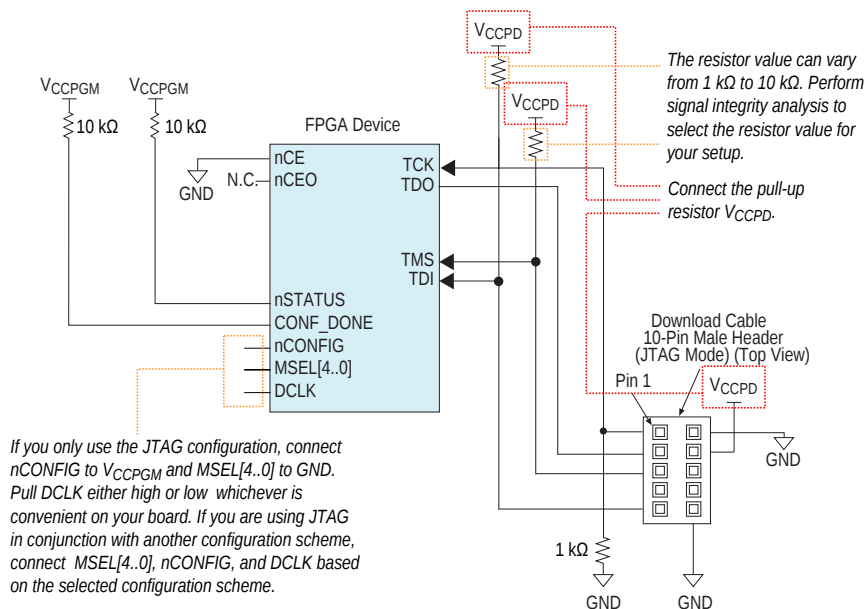
The Quartus II software can use the CONF_DONE pin to verify the completion of the configuration process through the JTAG port:

- CONF_DONE pin is low—indicates that configuration has failed.
- CONF_DONE pin is high—indicates that configuration was successful.

After the configuration data is transmitted serially using the JTAG TDI port, the TCK port is clocked an additional 1,222 cycles to perform device initialization.

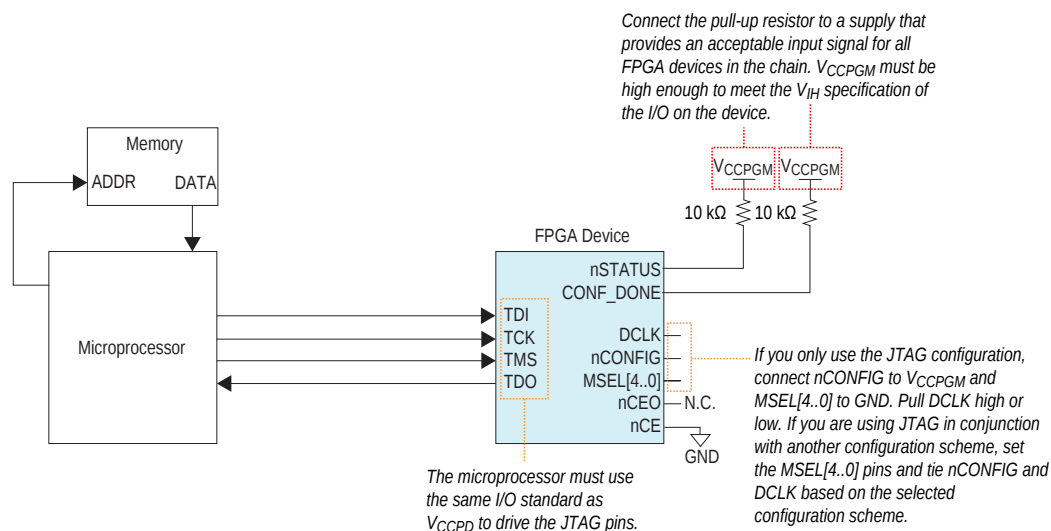
To configure a Cyclone V device using a download cable, connect the device as shown in the following figure.

Figure 7-17: JTAG Configuration of a Single Device Using a Download Cable



To configure a Cyclone V device using a microprocessor, connect the device as shown in the following figure. You can use JRunner as your software driver.

Figure 7-18: JTAG Configuration of a Single Device Using a Microprocessor



Related Information

AN 414: The JRunner Software Driver: An Embedded Solution for PLD JTAG Configuration

issue all JTAG instructions. Otherwise, you can only issue the `BYPASS`, `IDCODE`, and `SAMPLE` JTAG instructions.

You can use the `CONFIO_IO` JTAG instruction to interrupt configuration and perform board-level testing. After the board-level testing is completed, you must reconfigure your device. Use the following methods to reconfigure your device:

- JTAG interface—issue the `PULSE_NCONFIG` JTAG instruction.
- FPP, PS, or AS configuration scheme—pulse the `nCONFIG` pin low.

Configuration Data Compression

Cyclone V devices can receive compressed configuration bitstream and decompress the data in real-time during configuration. Preliminary data indicates that compression typically reduces the configuration file size by 30% to 55% depending on the design.

Decompression is supported in all configuration schemes except the JTAG configuration scheme.

You can enable compression before or after design compilation.

Enabling Compression Before Design Compilation

To enable compression before design compilation, follow these steps:

1. On the Assignment Menu, click **Device**.
2. Select your Cyclone V device and then click **Device and Pin Options**.
3. In the **Device and Pin Options** window, select **Configuration** under the **Category** list and turn on **Generate compressed bitstreams**.

Enabling Compression After Design Compilation

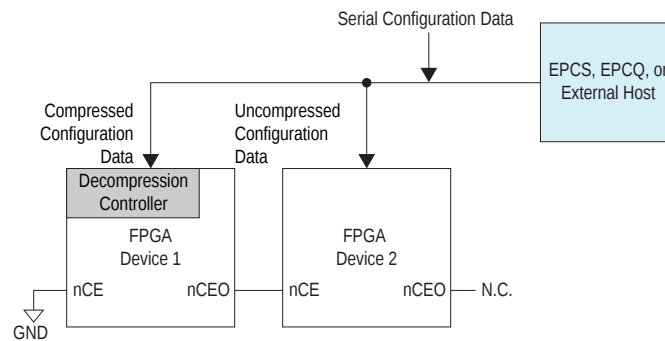
To enable compression after design compilation, follow these steps:

1. On the File menu, click **Convert Programming Files**.
2. Select the programming file type (`.pof`, `.sof`, `.hex`, `.hexout`, `.rbf`, or `.tff`). For POF output files, select a configuration device.
3. Under the **Input files to convert** list, select **SOF Data**.
4. Click **Add File** and select a Cyclone V device `.sof`.
5. Select the name of the file you added to the **SOF Data** area and click **Properties**.
6. Turn on the **Compression** check box.

Using Compression in Multi-Device Configuration

The following figure shows a chain of two Cyclone V devices. Compression is only enabled for the first device.

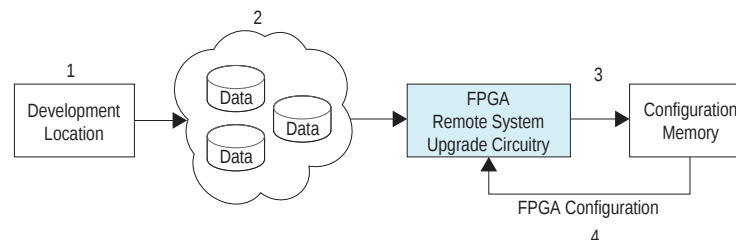
This setup is supported by the AS or PS multi-device configuration only.

Figure 7-20: Compressed and Uncompressed Serial Configuration Data in the Same Configuration File

For the FPP configuration scheme, a combination of compressed and uncompressed configuration in the same multi-device configuration chain is not allowed because of the difference on the DCLK-to-DATA[] ratio.

Remote System Upgrades

Cyclone V devices contain dedicated remote system upgrade circuitry. You can use this feature to upgrade your system from a remote location.

Figure 7-21: Cyclone V Remote System Upgrade Block Diagram

You can design your system to manage remote upgrades of the application configuration images in the configuration device. The following list is the sequence of the remote system upgrade:

1. The logic (embedded processor or user logic) in the Cyclone V device receives a configuration image from a remote location. You can connect the device to the remote source using communication protocols such as TCP/IP, PCI, user datagram protocol (UDP), UART, or a proprietary interface.
2. The logic stores the configuration image in non-volatile configuration memory.
3. The logic starts reconfiguration cycle using the newly received configuration image.
4. When an error occurs, the circuitry detects the error, reverts to a safe configuration image, and provides error status to your design.

Configuration Images

Each Cyclone V device in your system requires one factory image. The factory image is a user-defined configuration image that contains logic to perform the following:

- Processes errors based on the status provided by the dedicated remote system upgrade circuitry.
- Communicates with the remote host, receives new application images, and stores the images in the local non-volatile memory device.
- Determines the application image to load into the Cyclone V device.
- Enables or disables the user watchdog timer and loads its time-out value.
- Instructs the dedicated remote system upgrade circuitry to start a reconfiguration cycle.

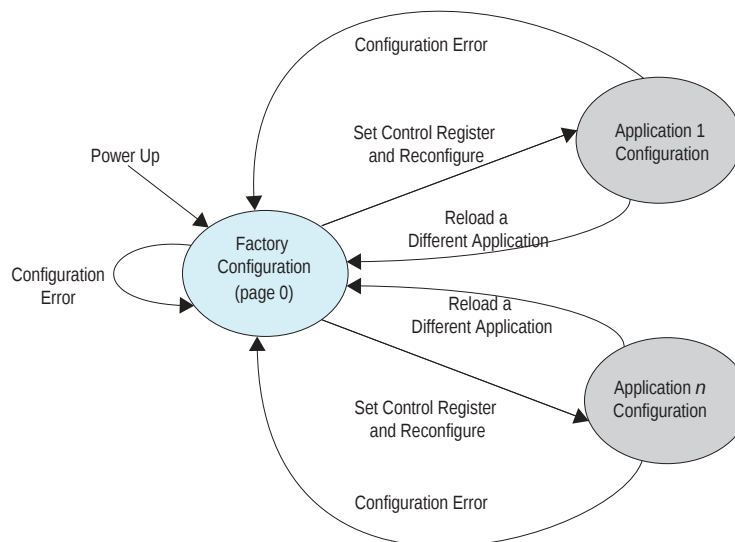
You can also create one or more application images for the device. An application image contains selected functionalities to be implemented in the target device.

Store the images at the following locations in the EPCS or EPCQ devices:

- Factory configuration image—PGM[23 . . 0] = 24'h000000 start address on the EPCS or EPCQ device.
- Application configuration image—any sector boundary. Altera recommends that you store only one image at one sector boundary.

Configuration Sequence in the Remote Update Mode

Figure 7-22: Transitions Between Factory and Application Configurations in Remote Update Mode



Related Information

[Remote System Upgrade State Machine](#) on page 7-32

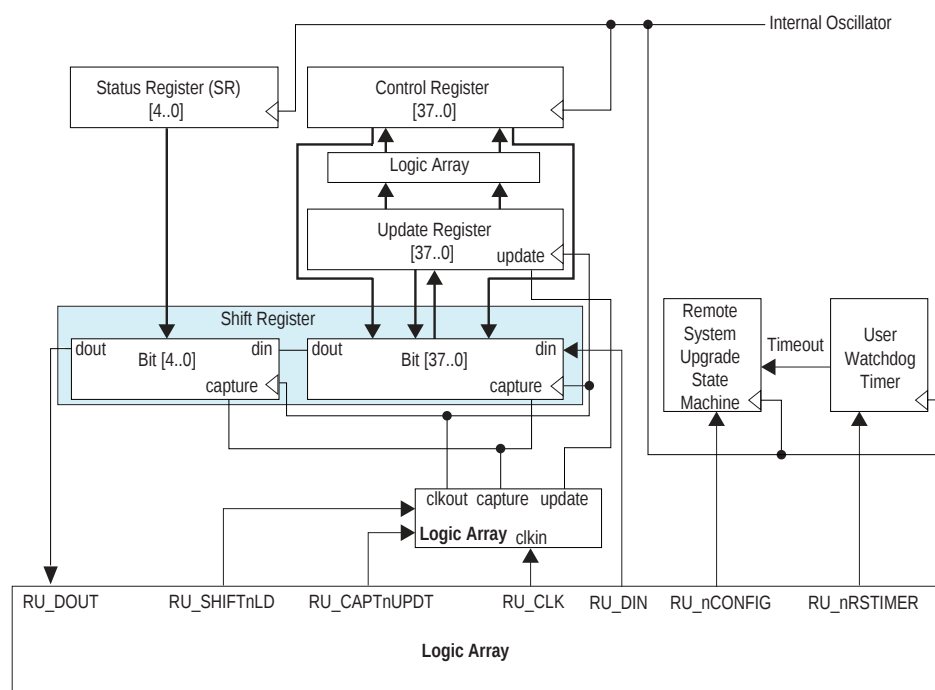
A detailed description of the configuration sequence in the remote update mode.

Remote System Upgrade Circuitry

The remote system upgrade circuitry contains the remote system upgrade registers, watchdog timer, and a state machine that controls these components.

Note: If you are using the ALTREMOTE_UPDATE megafunction, the megafunction controls the RU_DOUT, RU_SHIFTnLD, RU_CAPTnUPDT, RU_CLK, RU_DIN, RU_nCONFIG, and RU_nRSTIMER signals internally to perform all the related remote system upgrade operations.

Figure 7-23: Remote System Upgrade Circuitry



Related Information

[Cyclone V Device Datasheet](#)

Provides more information about remote system upgrade circuitry timing specifications.

Enabling Remote System Upgrade Circuitry

To enable the remote system upgrade feature, follow these steps:

1. Select **Active Serial x1** or **Configuration Device** from the Configuration scheme list in the **Configuration** page of the **Device and Pin Options** dialog box in the Quartus II software.
2. Select **Remote** from the Configuration mode list in the **Configuration** page of the **Device and Pin Options** dialog box in the Quartus II software.

Enabling this feature automatically turns on the **Auto-restart configuration after error** option.

Altera-provided ALTREMOTE_UPDATE megafunction provides a memory-like interface to the remote system upgrade circuitry and handles the shift register read and write protocol in the Cyclone V device logic.

Related Information

[Remote System Upgrade \(ALTREMOTE_UPDATE\) Megafunction User Guide](#)

Remote System Upgrade Registers

Table 7-6: Remote System Upgrade Registers

Register	Description
Shift	<p>Accessible by the logic array and clocked by RU_CLK.</p> <ul style="list-style-type: none">• <code>Bits[4..0]</code>—Contents of the status register are shifted into these bits.• <code>Bits[37..0]</code>—Contents of the update and control registers are shifted into these bits.
Control	<p>This register is clocked by the 10-MHz internal oscillator. The contents of this register are shifted to the shift register for the user logic in the application configuration to read. When reconfiguration is triggered, this register is updated with the contents of the update register.</p>
Update	<p>This register is clocked by RU_CLK. The factory configuration updates this register by shifting data into the shift register and issuing an update. When reconfiguration is triggered, the contents of the update register are written to the control register.</p>
Status	<p>After each reconfiguration, the remote system upgrade circuitry updates this register to indicate the event that triggered the reconfiguration. This register is clocked by the 10-MHz internal oscillator.</p>

Related Information

- [Control Register](#) on page 7-32
- [Status Register](#) on page 7-32

Control Register

Table 7-7: Control Register Bits

Bit	Name	Reset Value ⁽¹⁶⁾	Description
0	AnF	1'b0	Application not Factory bit. Indicates the configuration image type currently loaded in the device; 0 for factory image and 1 for application image. When this bit is 1 , the access to the control register is limited to read only and the watchdog timer is enabled. Factory configuration design must set this bit to 1 before triggering reconfiguration using an application configuration image.
1..24	PGM[0..23]	24'h000000	Upper 24 bits of AS configuration start address (StAdd[31..8]), the 8 LSB are zero.
25	Wd_en	1'b0	User watchdog timer enable bit. Set this bit to 1 to enable the watchdog timer.
26..37	Wd_timer[11..0]	12'b000000000000	User watchdog time-out value.

Status Register

Table 7-8: Status Register Bits

Bit	Name	Reset Value ⁽¹⁷⁾	Description
0	CRC	1'b0	When set to 1 , indicates CRC error during application configuration.
1	nSTATUS	1'b0	When set to 1 , indicates that nSTATUS is asserted by an external device due to error.
2	Core_nCONFIG	1'b0	When set to 1 , indicates that reconfiguration has been triggered by the logic array of the device.
3	nCONFIG	1'b0	When set to 1 , indicates that nCONFIG is asserted.
4	Wd	1'b0	When set to 1 , indicates that the user watchdog time-out.

Remote System Upgrade State Machine

The operation of the remote system upgrade state machine is as follows:

⁽¹⁶⁾ This is the default value after the device exits POR and during reconfiguration back to the factory configuration image.

⁽¹⁷⁾ After the device exits POR and power-up, the status register content is 5'b00000.

1. After power-up, the remote system upgrade registers are reset to **0** and the factory configuration image is loaded.
2. The user logic sets the AnF bit to **1** and the start address of the application image to be loaded. The user logic also writes the watchdog timer settings.
3. When the configuration reset (RU_CONFIG) goes low, the state machine updates the control register with the contents of the update register, and triggers reconfiguration using the application configuration image.
4. If error occurs, the state machine falls back to the factory image. The control and update registers are reset to **0**, and the status register is updated with the error information.
5. After successful reconfiguration, the system stays in the application configuration.

User Watchdog Timer

The user watchdog timer prevents a faulty application configuration from stalling the device indefinitely. You can use the timer to detect functional errors when an application configuration is successfully loaded into the device. The timer is automatically disabled in the factory configuration; enabled in the application configuration.

Note: If you do not want this feature in the application configuration, you need to turn off this feature by setting the Wd_en bit to **1'b0** in the update register during factory configuration user mode operation. You cannot disable this feature in the application configuration.

The counter is 29 bits wide and has a maximum count value of 2^{29} . When specifying the user watchdog timer value, specify only the most significant 12 bits. The granularity of the timer setting is 2^{17} cycles. The cycle time is based on the frequency of the user watchdog timer internal oscillator.

The timer begins counting as soon as the application configuration enters user mode. When the timer expires, the remote system upgrade circuitry generates a time-out signal, updates the status register, and triggers the loading of the factory configuration image. To reset the time, assert RU_nRSTIMER.

Related Information

[Cyclone V Device Datasheet](#)

Provides more information about the operating range of the user watchdog internal oscillator's frequency.

Design Security

The Cyclone V design security feature supports the following capabilities:

- Enhanced built-in advanced encryption standard (AES) decryption block to support 256-bit key industry-standard design security algorithm (FIPS-197 Certified)
- Volatile and non-volatile key programming support
- Secure operation mode for both volatile and non-volatile key through tamper protection bit setting
- Limited accessible JTAG instruction during power-up in the JTAG secure mode
- Supports board-level testing
- Supports in-socket key programming for non-volatile key
- Available in all configuration schemes except JTAG
- Supports both remote system upgrades and compression features

The Cyclone V design security feature provides the following security protection for your designs:

- Security against copying—the security key is securely stored in the Cyclone V device and cannot be read out through any interface. In addition, as configuration file read-back is not supported in Cyclone V devices, your design information cannot be copied.
- Security against reverse engineering—reverse engineering from an encrypted configuration file is very difficult and time consuming because the Cyclone V configuration file formats are proprietary and the file contains millions of bits that require specific decryption.
- Security against tampering—After you set the tamper protection bit, the Cyclone V device can only accept configuration files encrypted with the same key. Additionally, programming through the JTAG interface and configuration interface is blocked.

When you use compression with the design security feature, the configuration file is first compressed and then encrypted using the Quartus II software. During configuration, the device first decrypts and then decompresses the configuration file.

When you use design security with Cyclone V devices in an FPP configuration scheme, it requires a different DCLK-to-DATA[] ratio.

ALTCHIP_ID Megafunction

The ALTCHIP_ID megafunction provides the following features:

- Acquiring the chip ID of an FPGA device.
- Allowing you to identify your device in your design as part of a security feature to protect your design from an unauthorized device.

Related Information

[ALTCHIP_ID Megafunction User Guide](#)

JTAG Secure Mode

When you enable the tamper-protection bit, Cyclone V devices are in the JTAG secure mode after power-up. During this mode, many JTAG instructions are disabled. Cyclone V devices only allow mandatory JTAG 1149.1 instructions to be exercised. These JTAG instructions are SAMPLE / PRELOAD, BYPASS, EXTEST, and optional instructions such as IDCODE and SHIFT_EDERROR_REG.

To enable the access of other JTAG instructions such as USERCODE, HIGHZ, CLAMP, PULSE_nCONFIG, and CONFIG_IO, you must issue the UNLOCK instruction to deactivate the JTAG secure mode. You can issue the LOCK instruction to put the device back into JTAG secure mode. You can only issue both the LOCK and UNLOCK JTAG instructions during user mode.

Related Information

- [Supported JTAG Instruction](#) on page 9-3
Provides more information about JTAG binary instruction code related to the LOCK and UNLOCK instructions.
- [JTAG Boundary-Scan Testing in Cyclone V Devices](#)
Provides more information about JTAG binary instruction code related to the LOCK and UNLOCK instructions.

Security Key Types

Cyclone V devices offer two types of keys—volatile and non-volatile. The following table lists the differences between the volatile key and non-volatile keys.

Table 7-9: Security Key Types

Key Types	Key Programmability	Power Supply for Key Storage	Programming Method
Volatile	<ul style="list-style-type: none">ReprogrammableErasable	Required external battery, $V_{CCBAT}^{(18)}$	On-board
Non-volatile	One-time programming	Does not require an external battery	On-board and in-socket programming ⁽¹⁹⁾

Both non-volatile and volatile key programming offers protection from reverse engineering and copying. If you set the tamper-protection bit, the design is also protected from tampering.

You can perform key programming through the JTAG pins interface. Ensure that the nSTATUS pin is released high before any key-programming attempts.

Note: To clear the volatile key, issue the KEY_CLR_VREG JTAG instruction. To verify the volatile key has been cleared, issue the KEY_VERIFY JTAG instruction.

Related Information

- [Supported JTAG Instruction](#) on page 9-3
Provides more information about the KEY_CLR_VREG and KEY_VERIFY instructions.
- [JTAG Boundary-Scan Testing in Cyclone V Devices](#)
Provides more information about the KEY_CLR_VREG and KEY_VERIFY JTAG instructions.
- [Cyclone V Device Family Pin Connection Guidelines](#)
Provides more information about the V_{CCBAT} pin connection recommendations.
- [Cyclone V Device Datasheet](#)
Provides more information about battery specifications.

Security Modes

Table 7-10: Supported Security Modes

Security Mode	Tamper Protection Bit Setting	Device Accepts Unencrypted File	Device Accepts Encrypted File	Security Level
No key	—	Yes	No	—
Volatile Key	—	Yes	Yes	Secure

⁽¹⁸⁾ V_{CCBAT} is a dedicated power supply for volatile key storage. V_{CCBAT} continuously supplies power to the volatile register regardless of the on-chip supply condition.

⁽¹⁹⁾ Third-party vendors offer in-socket programming.

Security Mode	Tamper Protection Bit Setting	Device Accepts Unencrypted File	Device Accepts Encrypted File	Security Level
Volatile Key with Tamper Protection Bit Set	Set	No	Yes	Secure with tamper resistant
Non-volatile Key	—	Yes	Yes	Secure
Non-volatile Key with Tamper Protection Bit Set	Set	No	Yes	Secure with tamper resistant

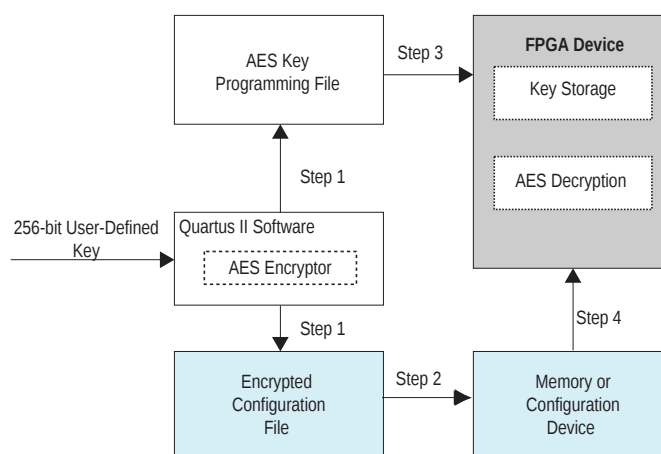
The use of unencrypted configuration bitstream in the volatile key and non-volatile key security modes is supported for board-level testing only.

Note: For the volatile key with tamper protection bit set security mode, Cyclone V devices do not accept the encrypted configuration file if the volatile key is erased. If the volatile key is erased and you want to reprogram the key, you must use the volatile key security mode.

Enabling the tamper protection bit disables the test mode in Cyclone V devices and disables programming through the JTAG interface. This process is irreversible and prevents Altera from carrying out failure analysis.

Design Security Implementation Steps

Figure 7-24: Design Security Implementation Steps



To carry out secure configuration, follow these steps:

1. The Quartus II software generates the design security key programming file and encrypts the configuration data using the user-defined 256-bit security key.
2. Store the encrypted configuration file in the external memory.
3. Program the AES key programming file into the Cyclone V device through a JTAG interface.
4. Configure the Cyclone V device. At the system power-up, the external memory device sends the encrypted configuration file to the Cyclone V device.

Document Revision History

Date	Version	Changes
June 2013	2013.06.11	Updated the Configuration Error Handling section.
May 2013	2013.05.10	Removed support for active serial multi-device configuration using the same configuration data.
May 2013	2013.05.06	<ul style="list-style-type: none">Added link to the known document issues in the Knowledge Base.Added the ALTCHIP_ID megafunction section.Updated "Connection Setup for Programming the EPCS Using the JTAG Interface" and "Connection Setup for Programming the EPCQ Using the JTAG Interface" figures.Added links for AS, PS, FPP, and JTAG configuration timing to device datasheet.Updated CvP support for partial reconfiguration in the Table 7-1: Configuration Modes and Features Supported by Cyclone V Devices.Moved all links to the Related Information section of respective topics for easy reference.
December 2012	2012.12.28	<ul style="list-style-type: none">Added configuration modes and features for Cyclone V devices.Added PR_REQUEST, PR_READY, PR_ERROR, and PR_DONE pins to Configuration Pin Options table.Reorganized content and updated template.
June 2012	2.0	Restructured the chapter.
November 2011	1.1	Updated Table 7-4.
October 2011	1.0	Initial release.

2013.11.12

CV-52008



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This chapter describes the error detection features in Cyclone V devices. You can use these features to mitigate single event upset (SEU) or soft errors.

Related Information

[Cyclone V Device Handbook: Known Issues](#)

Lists the planned updates to the *Cyclone V Device Handbook* chapters.

Error Detection Features

The on-chip error detection CRC circuitry allows you to perform the following operations without any impact on the fitting or performance of the device:

- Auto-detection of CRC errors during configuration.
- Optional CRC error detection and identification in user mode.
- Testing of error detection functions by deliberately injecting errors through the JTAG interface.

Configuration Error Detection

When the Quartus II software generates the configuration bitstream, the software also computes a 16-bit CRC value for each frame. A configuration bitstream can contain more than one CRC values depending on the number of data frames in the bitstream. The length of the data frame varies for each device.

When a data frame is loaded into the FPGA during configuration, the precomputed CRC value shifts into the CRC circuitry. At the same time, the CRC engine in the FPGA computes the CRC value for the data frame and compares it against the precomputed CRC value. If both CRC values do not match, the nSTATUS pin is set to low to indicate a configuration error.

You can test the capability of this feature by modifying the configuration bitstream or intentionally corrupting the bitstream during configuration.

User Mode Error Detection

In user mode, the contents of the configured CRAM bits may be affected by soft errors. These soft errors, which are caused by an ionizing particle, are not common in Altera devices. However, high-reliability

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applications that require the device to operate error-free may require that your designs account for these errors.

You can enable the error detection circuitry to detect soft errors. Each data frame stored in the CRAM contains a 32-bit precomputed CRC value. When this feature is enabled, the error detection circuitry continuously computes a 32-bit CRC value for each frame in the CRAM and compares the CRC value against the precomputed value.

- If the CRC values match, the 32-bit CRC signature in the `syndrome` register is set to zero to indicate that no error is detected.
- Otherwise, the resulting 32-bit CRC signature in the `syndrome` register is non-zero to indicate a CRC error. The `CRC_ERROR` pin is pulled high, and the error type and location are identified.

Within a frame, the error detection circuitry can detect all single-, double-, triple-, quadruple-, and quintuple-bit errors. When a single-bit or double-adjacent error is detected, the error detection circuitry reports the bit location and determines the error type for single-bit and double-adjacent errors. The probability of other error patterns is very low and the reporting of bit location is not guaranteed. The probability of more than five CRAM bits being flipped by soft errors is very low. In general, the probability of detection for all error patterns is 99.9999%. The process of error detection continues until the device is reset by setting the `nCONFIG` signal low.

Specifications

This section lists the EMR update interval, error detection frequencies, and CRC calculation time for error detection in user mode.

Minimum EMR Update Interval

The interval between each update of the error message register depends on the device and the frequency of the error detection clock. Using a lower clock frequency increases the interval time, hence increasing the time required to recover from a single event upset (SEU).

Table 8-1: Estimated Minimum EMR Update Interval in Cyclone V Devices

Variant	Member Code	Timing Interval (μ s)
Cyclone E	A2	1.47
	A4	1.47
	A5	1.79
	A7	2.33
	A9	3.23
Cyclone V GX	C3	1.09
	C4	1.79
	C5	1.79
	C7	2.33
	C9	3.23

Variant	Member Code	Timing Interval (μs)
Cyclone V GT	D5	1.79
	D7	2.33
	D9	3.23
Cyclone V SE	A2	1.77
	A4	1.77
	A5	2.31
	A6	2.31
Cyclone V SX	C4	1.77
	C5	2.31
	C6	2.31
Cyclone V ST	D5	2.31
	D6	2.31

Error Detection Frequency

You can control the speed of the error detection process by setting the division factor of the clock frequency in the Quartus II software. The divisor is 2^n , where n can be any value listed in the following table.

The speed of the error detection process for each data frame is determined by the following equation:

Figure 8-1: Error Detection Frequency Equation

$$\text{Error Detection Frequency} = \frac{\text{Internal Oscillator Frequency}}{2^n}$$

Table 8-2: Error Detection Frequency Range for Cyclone V Devices

The following table lists the frequencies and valid values of n .

Internal Oscillator Frequency	Error Detection Frequency		n	Divisor Range
	Maximum	Minimum		
100 MHz	100 MHz	390 kHz	0, 1, 2, 3, 4, 5, 6, 7, 8	1 – 256

CRC Calculation Time

The time taken by the error detection circuitry to calculate the CRC for each frame is determined by the device in use and the frequency of the error detection clock.

You can calculate the minimum and maximum time for any number of divisor based on the following formula:

Maximum time (n) = $2^{(n-8)}$ * maximum time

Minimum time (n) = 2^n * minimum time

where the range of n is from 0 to 8.

Table 8-3: CRC Calculation Time in Cyclone V Devices

The following table lists the minimum and maximum time taken to calculate the CRC value:

- The minimum time is derived using the maximum clock frequency with a divisor of 0.
- The maximum time is derived using the minimum clock frequency with a divisor of 8.

Variant	Member Code	Minimum Time (ms)	Maximum Time (s)
Cyclone E	A2	4	2.08
	A4	4	2.08
	A5	7	3.54
	A7	7	3.62
	A9	15	7.40
Cyclone V GX	C3	8	4.05
	C4	7	3.54
	C5	7	3.54
	C7	7	3.62
	C9	15	7.40
Cyclone V GT	D5	7	3.54
	D7	7	3.62
	D9	15	7.40
Cyclone V SE	A2	7	3.59
	A4	7	3.59
	A5	13	6.30
	A6	13	6.30
Cyclone V SX	C4	7	3.59
	C5	13	6.30
	C6	13	6.30
Cyclone V ST	D5	13	6.30
	D6	13	6.30

Using Error Detection Features in User Mode

This section describes the pin, registers, process flow, and procedures for error detection in user mode.

Enabling Error Detection

To enable user mode error detection in the Quartus II software, follow these steps:

1. On the Assignments menu, click **Device**.
2. In the Device dialog box, click **Device and Pin Options**.

- 3. In the **Category** list, click **Error Detection CRC**.
- 4. Turn on **Enable Error Detection CRC_ERROR pin**.
- 5. To set the CRC_ERROR pin as output open drain, turn on **Enable open drain on CRC_ERROR pin**. Turning off this option sets the CRC_ERROR pin as output.
- 6. In the **Divide error check frequency by** list, select a valid divisor.
- 7. Click OK.

CRC_ERROR Pin

Table 8-4: Pin Description

Pin Name	Pin Type	Description
CRC_ERROR	I/O or output/ output open-drain	<p>An active-high signal, when driven high indicates that an error is detected in the CRAM bits. This pin is only used when you enable error detection in user mode. Otherwise, the pin is used as a user I/O pin.</p> <p>When using the WYSIWYG function, you can route the <code>crcerror</code> port from the WYSIWYG atom to the dedicated CRC_ERROR pin or any user I/O pin. To route the <code>crcerror</code> port to a user I/O pin, insert a D-type flipflop between them.</p>

Error Detection Registers

This section describes the registers used in user mode.

Figure 8-2: Block Diagram for Error Detection in User Mode

The block diagram shows the registers and data flow in user mode.

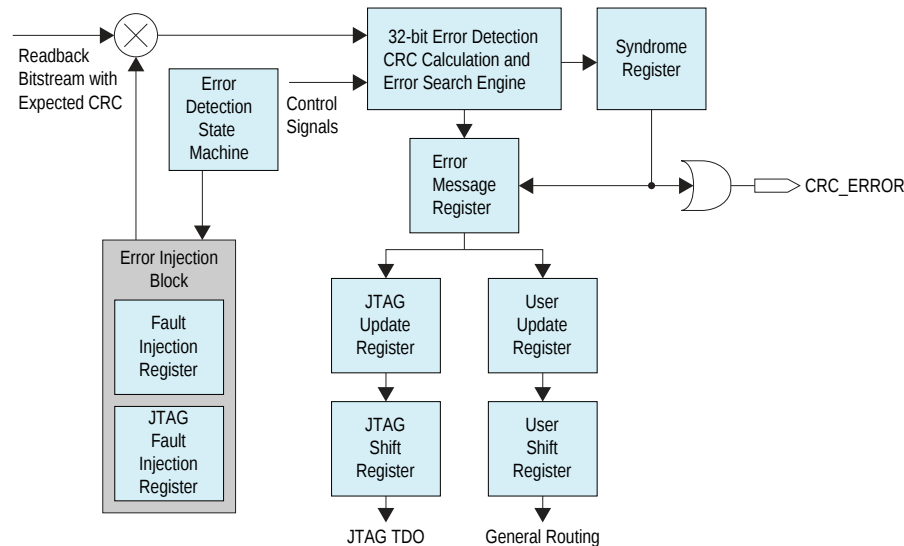


Table 8-5: Error Detection Registers

Name	Width (Bits)	Description
Syndrome register	32	Contains the 32-bit CRC signature calculated for the current frame. If the CRC value is 0, the CRC_ERROR pin is driven low to indicate no error. Otherwise, the pin is pulled high.
Error message register (EMR)	67	Contains error details for single-bit and double-adjacent errors. The error detection circuitry updates this register each time the circuitry detects an error. Figure 8-3 shows the fields in this register and Table 8-6 lists the possible error types.
JTAG update register	67	This register is automatically updated with the contents of the EMR one clock cycle after the content of this register is validated. The JTAG update register includes a clock enable, which must be asserted before its contents are written to the JTAG shift register. This requirement ensures that the JTAG update register is not overwritten when its contents are being read by the JTAG shift register.
JTAG shift register	67	This register allows you to access the contents of the JTAG update register via the JTAG interface using the SHIFT_EDERROR_REG JTAG instruction.
User update register	67	This register is automatically updated with the contents of the EMR one clock cycle after the contents of this register are validated. The user update register includes a clock enable, which must be asserted before its contents are written to the user shift register. This requirement ensures that the user update register is not overwritten when its contents are being read by the user shift register.
User shift register	67	This register allows user logic to access the contents of the user update register via the core interface.
JTAG fault injection register	46	You can use this register with the EDERROR_INJECT JTAG instruction to inject errors in the bitstream. Table 8-7 lists the fields in this register.
Fault injection register	46	This register is updated with the contents of the JTAG fault injection register.

Figure 8-3: Error Message Register Map

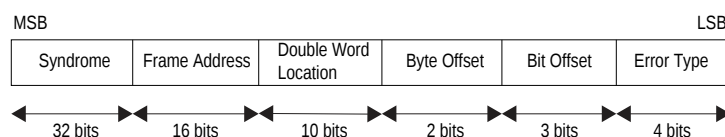


Table 8-6: Error Type in EMR

The following table lists the possible error types reported in the error type field in the EMR.

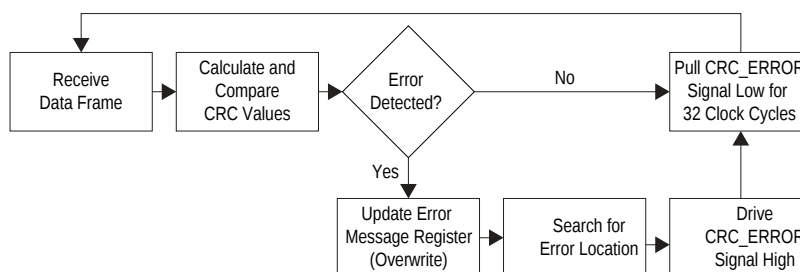
Error Type				Description
Bit 3	Bit 2	Bit 1	Bit 0	
0	0	0	0	No CRC error.
0	0	0	1	Location of a single-bit error is identified.
0	0	1	0	Location of a double-adjacent error is identified.
1	1	1	1	Error types other than single-bit and double-adjacent errors.

Table 8-7: JTAG Fault Injection Register Map

Field Name	Bit Range				Description
Error Byte Value	31:0				Contains the location of the bit error that corresponds to the error injection type to this field.
Byte Location	41:32				Contains the location of the injected error in the first data frame.
Error Type	45:42				Specifies the following error types.
	Bit 45	Bit 44	Bit 43	Bit 42	
	0	0	0	0	No error
	0	0	0	1	Single-bit error
	0	0	1	0	Double adjacent error

Error Detection Process

When enabled, the user mode error detection process activates automatically when the FPGA enters user mode. The process continues to run until the device is reset even when an error is detected in the current frame.

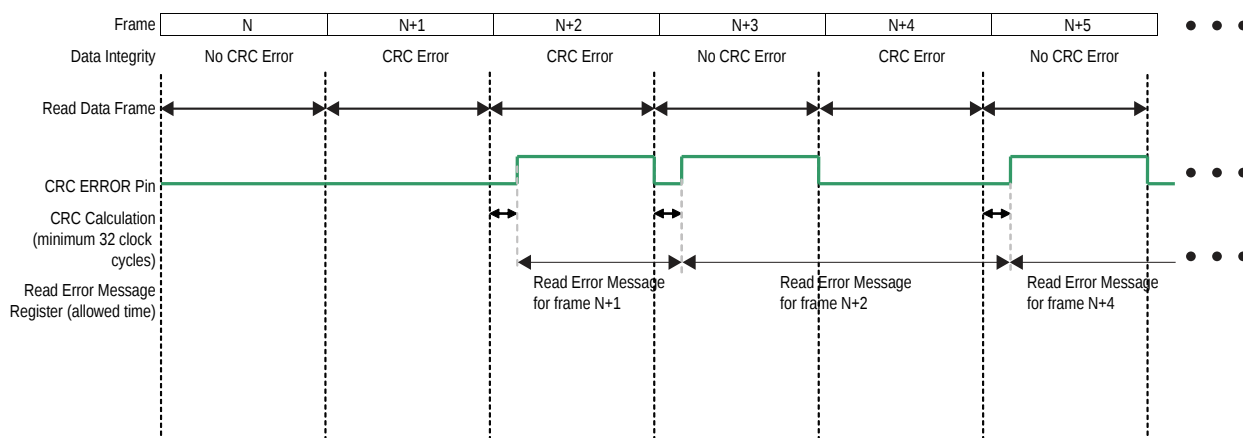
Figure 8-4: Error Detection Process Flow in User Mode

Timing

The CRC_ERROR pin is always driven low during CRC calculation for a minimum of 32 clock cycles. When an error occurs, the pin is driven high once the EMR is updated or 32 clock cycles have lapsed, whichever

comes last. Therefore, you can start retrieving the contents of the EMR at the rising edge of the `CRC_ERROR` pin. The pin stays high until the current frame is read and then driven low again for a minimum of 32 clock cycles. To ensure information integrity, complete the read operation within one frame of the CRC verification. The following diagram shows the timing of these events.

Figure 8-5: Timing Requirements



Retrieving Error Information

You can retrieve the error information via the core interface or the JTAG interface using the `SHIFT_EDERROR_REG` JTAG instruction.

Recovering from CRC Errors

The system that hosts the FPGA must control device reconfiguration. To recover from a CRC error, drive the `nCONFIG` signal low. The system waits for a safe time before reconfiguring the device. When reconfiguration completes successfully, the FPGA operates as intended.

Related Information

- [Error Detection Frequency](#) on page 8-3
Provides more information about the minimum and maximum error detection frequencies.
- [Minimum EMR Update Interval](#) on page 8-2
Provides more information about the duration of each Cyclone V device.
- [Test Methodology of Error Detection and Recovery using CRC in Altera FPGA Devices](#)
Provides more information about how to retrieve the error information.

Testing the Error Detection Block

You can inject errors into the configuration data to test the error detection block. This error injection methodology provides design verification and system fault tolerance characterization.

Testing via the JTAG Interface

You can intentionally inject single or double-adjacent errors into the configuration data using the `EDERROR_INJECT` JTAG instruction.

Table 8-8: EDERROR_INJECT instruction

JTAG Instruction	Instruction Code	Description
EDERROR_INJECT	00 0001 0101	Use this instruction to inject errors into the configuration data. This instruction controls the JTAG fault injection register, which contains the error you want to inject into the bitstream.

You can only inject errors into the first frame of the configuration data. However, you can monitor the error information at any time. Altera recommends that you reconfigure the FPGA after the test completes.

Automating the Testing Process

You can automate the testing process by creating a Jam™ file (.jam). Using this file, you can verify the CRC functionality in-system and on-the-fly without reconfiguring the device. You can then switch to the CRC circuitry to check for real errors caused by an SEU.

Related Information

[Test Methodology of Error Detection and Recovery using CRC in Altera FPGA Devices](#)

Provides more information about how to test the error detection block.

Document Revision History

Date	Version	Changes
November 2013	2013.11.12	<ul style="list-style-type: none">Updated the CRC Calculation Time section to include a formula to calculate the minimum and maximum time.Removed preliminary for the Minimum EMR Update Interval and CRC Calculation Time.Removed related information for the Internal Scrubbing feature.
May 2013	2013.05.06	<ul style="list-style-type: none">Added link to the known document issues in the Knowledge Base.Updated the minimum EMR Update Interval and CRC Calculation Time for Cyclone V E, Cyclone V GX, and Cyclone V GT devices.Moved all links to the Related Information section of respective topics for easy reference.
December 2012	2012.12.28	<ul style="list-style-type: none">Updated the width of the JTAG fault injection and fault injection registers.
June 2012	2.0	<ul style="list-style-type: none">Added the “Basic Description”, “Error Detection Features”, “Types of Error Detection”, “Error Detection Components”, “Using the Error Detection Feature”, and “Testing the Error Detection Block” sections.Updated Table 8–4, Table 8–5, and Table 8–6.Restructured the chapter.
October 2011	1.0	Initial release.

2013.05.06

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This chapter describes the boundary-scan test (BST) features in Cyclone V devices.

Related Information

- **JTAG Configuration** on page 7-23
Provides more information about JTAG configuration.
- **Cyclone V Device Handbook: Known Issues**
Lists the planned updates to the *Cyclone V Device Handbook* chapters.

BST Operation Control

Cyclone V devices support IEEE Std. 1149.1 BST. You can perform BST on Cyclone V devices before, after, and during configuration.

IDCODE

The IDCODE is unique for each Cyclone V device. Use this code to identify the devices in a JTAG chain.

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Table 9-1: IDCODE Information for Cyclone V Devices

Variant	Member Code	IDCODE (32 Bits)			
		Version (4 Bits)	Part Number (16 Bits)	Manufacture Identity (11 Bits)	LSB (1 Bit)
Cyclone V E	A2	0000	0010 1011 0001 0101	000 0110 1110	1
	A4	0000	0010 1011 0000 0101	000 0110 1110	1
	A5	0000	0010 1011 0010 0010	000 0110 1110	1
	A7	0000	0010 1011 0001 0011	000 0110 1110	1
	A9	0000	0010 1011 0001 0100	000 0110 1110	1
Cyclone V GX	C3	0000	0010 1011 0000 0001	000 0110 1110	1
	C4	0000	0010 1011 0001 0010	000 0110 1110	1
	C5	0000	0010 1011 0000 0010	000 0110 1110	1
	C7	0000	0010 1011 0000 0011	000 0110 1110	1
	C9	0000	0010 1011 0000 0100	000 0110 1110	1
Cyclone V GT	D5	0000	0010 1011 0000 0010	000 0110 1110	1
	D7	0000	0010 1011 0000 0011	000 0110 1110	1
	D9	0000	0010 1011 0000 0100	000 0110 1110	1
Cyclone V SE	A2	0000	0010 1101 0001 0001	000 0110 1110	1
	A4	0000	0010 1101 0000 0001	000 0110 1110	1
	A5	0000	0010 1101 0001 0010	000 0110 1110	1
	A6	0000	0010 1101 0000 0010	000 0110 1110	1

Variant	Member Code	IDCODE (32 Bits)			
		Version (4 Bits)	Part Number (16 Bits)	Manufacture Identity (11 Bits)	LSB (1 Bit)
Cyclone V SX	C2	0000	0010 1101 0001 0001	000 0110 1110	1
	C4	0000	0010 1101 0000 0001	000 0110 1110	1
	C5	0000	0010 1101 0001 0010	000 0110 1110	1
	C6	0000	0010 1101 0000 0010	000 0110 1110	1
Cyclone V ST	D5	0000	0010 1101 0001 0010	000 0110 1110	1
	D6	0000	0010 1101 0000 0010	000 0110 1110	1

Supported JTAG Instruction

Table 9-2: JTAG Instructions Supported by Cyclone V Devices

JTAG Instruction	Instruction Code	Description
SAMPLE/PRELOAD	00 0000 0101	<ul style="list-style-type: none"> Allows you to capture and examine a snapshot of signals at the device pins during normal device operation and permits an initial data pattern to be an output at the device pins. Use this instruction to preload the test data into the update registers before loading the EXTEST instruction. Used by the SignalTap™ II Embedded Logic Analyzer.
EXTEST	00 0000 1111	<ul style="list-style-type: none"> Allows you to test the external circuit and board-level interconnects by forcing a test pattern at the output pins, and capturing the test results at the input pins. Forcing known logic high and low levels on output pins allows you to detect opens and shorts at the pins of any device in the scan chain. The high-impedance state of EXTEST is overridden by bus hold and weak pull-up resistor features.

JTAG Instruction	Instruction Code	Description
BYPASS	11 1111 1111	Places the 1-bit bypass register between the TDI and TDO pins. During normal device operation, the 1-bit bypass register allows the BST data to pass synchronously through the selected devices to adjacent devices.
USERCODE	00 0000 0111	<ul style="list-style-type: none"> Examines the user electronic signature (UES) within the devices along a JTAG chain. Selects the 32-bit USERCODE register and places it between the TDI and TDO pins to allow serial shifting of USERCODE out of TDO. The UES value is set to default value before configuration and is only user-defined after the device is configured.
IDCODE	00 0000 0110	<ul style="list-style-type: none"> Identifies the devices in a JTAG chain. If you select IDCODE, the device identification register is loaded with the 32-bit vendor-defined identification code. Selects the IDCODE register and places it between the TDI and TDO pins to allow serial shifting of IDCODE out of TDO. IDCODE is the default instruction at power up and in the TAP RESET state. Without loading any instructions, you can go to the SHIFT_DR state and shift out the JTAG device ID.
HIGHZ	00 0000 1011	<ul style="list-style-type: none"> Sets all user I/O pins to an inactive drive state. Places the 1-bit bypass register between the TDI and TDO pins. During normal operation, the 1-bit bypass register allows the BST data to pass synchronously through the selected devices to adjacent devices while tri-stating all I/O pins until a new JTAG instruction is executed. If you are testing the device after configuration, the programmable weak pull-up resistor or the bus hold feature overrides the HIGHZ value at the pin.

JTAG Instruction	Instruction Code	Description
CLAMP	00 0000 1010	<ul style="list-style-type: none"> Places the 1-bit bypass register between the TDI and TDO pins. During normal operation, the 1-bit bypass register allows the BST data to pass synchronously through the selected devices to adjacent devices while holding the I/O pins to a state defined by the data in the boundary-scan register. If you are testing the device after configuration, the programmable weak pull-up resistor or the bus hold feature overrides the CLAMP value at the pin. The CLAMP value is the value stored in the update register of the boundary-scan cell (BSC).
PULSE_NCONFIG	00 0000 0001	Emulates pulsing the nCONFIG pin low to trigger reconfiguration even though the physical pin is not affected.
CONFIG_IO	00 0000 1101	Allows I/O reconfiguration (after or during reconfigurations) through the JTAG ports using I/O configuration shift register (IOCSR) for JTAG testing. You can issue the CONFIG_IO instruction only after the nSTATUS pin goes high.
LOCK	01 1111 0000	Put the device in JTAG secure mode. In this mode, only BYPASS, SAMPLE/PRELOAD, EXTEST, IDCODE, SHIFT_EDERROR_REG, and UNLOCK instructions are supported. This instruction can only be accessed through JTAG core access in user mode. It cannot be accessed through external JTAG pins in test or user mode.
UNLOCK	11 0011 0001	Release the device from the JTAG secure mode to enable access to all other JTAG instructions. This instruction can only be accessed through JTAG core access in user mode. It cannot be accessed through external JTAG pins in test or user mode.
KEY_CLR_VREG	00 0010 1001	Clears the non-volatile key.
KEY_VERIFY	00 0001 0011	Verifies the non-volatile key has been cleared.

Note: If the device is in a reset state and the `nCONFIG` or `nSTATUS` signal is low, the device `IDCODE` might not be read correctly. To read the device `IDCODE` correctly, you must issue the `IDCODE` JTAG instruction only when the `nCONFIG` and `nSTATUS` signals are high.

Related Information

- [JTAG Secure Mode](#) on page 7-34
Provides more information about `PULSE_NCONFIG`, `CONFIG_IO`, `LOCK`, and `UNLOCK` JTAG instructions.
- [Configuration, Design Security, and Remote System Upgrades in Cyclone V Devices](#)
Provides more information about `PULSE_NCONFIG`, `CONFIG_IO`, `LOCK`, and `UNLOCK` JTAG instructions.

JTAG Secure Mode

If you enable the tamper-protection bit, the Cyclone V device is in JTAG secure mode after power up. In the JTAG secure mode, the JTAG pins support only the `BYPASS`, `SAMPLE/PRELOAD`, `EXTEST`, `IDCODE`, `SHIFT_EDERROR_REG`, and `UNLOCK` instructions. Issue the `UNLOCK` JTAG instruction to enable support for other JTAG instructions.

JTAG Private Instruction

Caution: Never invoke the following instruction codes. These instructions can damage and render the device unusable:

- 1100010000
- 0011001001
- 1100010011
- 1100010111
- 0111100000
- 1110110011
- 0011100101
- 0011100110
- 0000101010
- 0000101011

I/O Voltage for JTAG Operation

The Cyclone V device operating in IEEE Std. 1149.1 BST mode uses four dedicated JTAG pins—`TDI`, `TDO`, `TMS`, and `TCK`. Cyclone V devices do not support the optional `TRST` pin.

The `TCK` pin has an internal weak pull-down resistor, while the `TDI` and `TMS` pins have internal weak pull-up resistors. The 3.3-, 3.0-, or 2.5-V V_{CCPD} supply of I/O bank 3A powers the `TDO`, `TDI`, `TMS`, and `TCK` pins. All user I/O pins are tri-stated during JTAG configuration.

The JTAG chain supports several different devices. Use the supported `TDO` and `TDI` voltage combinations listed in the following table if the JTAG chain contains devices that have different V_{CCIO} levels. The output voltage level of the `TDO` pin must meet the specification of the `TDI` pin it drives.

Table 9-3: Supported TDO and TDI Voltage Combinations

The TDO output buffer for V_{CCPD} of 3.3 V or 3.0 V meets V_{OH} (MIN) of 2.4 V, and the TDO output buffer for V_{CCPD} of 2.5 V meets V_{OH} (MIN) of 2.0 V.

Device	TDI Input Buffer Power (V)	Cyclone V TDO V_{CCPD}		
		$V_{CCPD} = 3.3 \text{ V}$	$V_{CCPD} = 3.0 \text{ V}$	$V_{CCPD} = 2.5 \text{ V}$
Cyclone V	$V_{CCPD} = 3.3$	Yes	Yes	Yes
	$V_{CCPD} = 3.0$	Yes	Yes	Yes
	$V_{CCPD} = 2.5$	Yes	Yes	Yes
Non-Cyclone V ⁽²⁰⁾	$V_{CC} = 3.3$	Yes	Yes	Yes
	$V_{CC} = 2.5$	Yes	Yes	Yes
	$V_{CC} = 1.8$	Yes	Yes	Yes
	$V_{CC} = 1.5$	Yes	Yes	Yes

Performing BST

You can issue BYPASS, IDCODE, and SAMPLE JTAG instructions before, after, or during configuration without having to interrupt configuration.

To issue other JTAG instructions, follow these guidelines:

- To perform testing before configuration, hold the nCONFIG pin low.
- To perform BST during configuration, issue CONFIG_IO JTAG instruction to interrupt configuration. While configuration is interrupted, you can issue other JTAG instructions to perform BST. After BST is completed, issue the PULSE_CONFIG JTAG instruction or pulse nCONFIG low to reconfigure the device.

The chip-wide reset (DEV_CLRn) and chip-wide output enable (DEV_OE) pins on Cyclone V devices do not affect JTAG boundary-scan or configuration operations. Toggling these pins does not disrupt BST operation (other than the expected BST behavior).

If you design a board for JTAG configuration of Cyclone V devices, consider the connections for the dedicated configuration pins.

Related Information

- [Cyclone V Device Family Pin Connection Guidelines](#)
Provides more information about pin connections.
- [Configuration, Design Security, and Remote System Upgrades in Cyclone V Devices](#)
Provides more information about JTAG configuration.
- [Cyclone V Device Datasheet](#)
Provides more information about JTAG configuration timing.

⁽²⁰⁾ The input buffer must be tolerant to the TDO V_{CCPD} voltage.

Enabling and Disabling IEEE Std. 1149.1 BST Circuitry

The IEEE Std. 1149.1 BST circuitry is enabled after the Cyclone V device powers up. However for Cyclone V SoC FPGAs, you must power up both HPS and FPGA to perform BST.

To ensure that you do not inadvertently enable the IEEE Std. 1149.1 circuitry when it is not required, disable the circuitry permanently with pin connections as listed in the following table.

Table 9-4: Pin Connections to Permanently Disable the IEEE Std. 1149.1 Circuitry for Cyclone V Devices

JTAG Pins ⁽²¹⁾	Connection for Disabling
TMS	V _{CCPD} supply of Bank 3A
TCK	GND
TDI	V _{CCPD} supply of Bank 3A
TDO	Leave open

Guidelines for IEEE Std. 1149.1 Boundary-Scan Testing

Consider the following guidelines when you perform BST with IEEE Std. 1149.1 devices:

- If the “10...” pattern does not shift out of the instruction register through the TDO pin during the first clock cycle of the SHIFT_IR state, the TAP controller did not reach the proper state. To solve this problem, try one of the following procedures:
 - Verify that the TAP controller has reached the SHIFT_IR state correctly. To advance the TAP controller to the SHIFT_IR state, return to the RESET state and send the 01100 code to the TMS pin.
 - Check the connections to the VCC, GND, JTAG, and dedicated configuration pins on the device.
- Perform a SAMPLE/PRELOAD test cycle before the first EXTEST test cycle to ensure that known data is present at the device pins when you enter EXTEST mode. If the OEJ update register contains 0, the data in the OUTJ update register is driven out. The state must be known and correct to avoid contention with other devices in the system.
- Do not perform EXTEST testing during in-circuit reconfiguration because EXTEST is not supported during in-circuit reconfiguration. To perform testing, wait for the configuration to complete or issue the CONFIG_IO instruction to interrupt configuration.
- After configuration, you cannot test any pins in a differential pin pair. To perform BST after configuration, edit and redefine the BSC group that correspond to these differential pin pairs as an internal cell.

Related Information

[IEEE 1149.1 BSDL Files](#)

Provides more information about BSC group definitions.

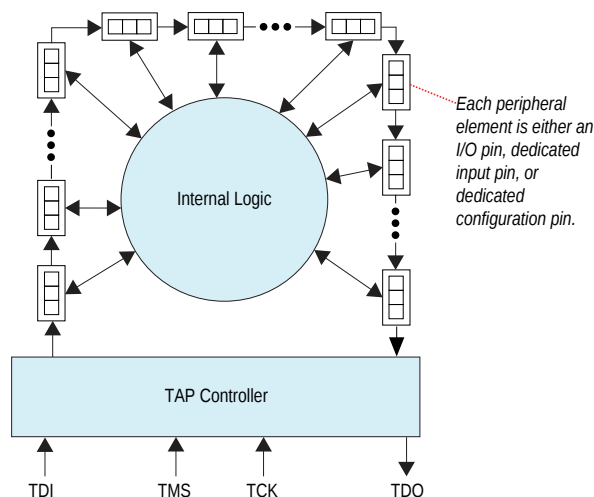
⁽²¹⁾ The JTAG pins are dedicated. Software option is not available to disable JTAG in Cyclone V devices.

IEEE Std. 1149.1 Boundary-Scan Register

The boundary-scan register is a large serial shift register that uses the TDI pin as an input and the TDO pin as an output. The boundary-scan register consists of 3-bit peripheral elements that are associated with Cyclone V I/O pins. You can use the boundary-scan register to test external pin connections or to capture internal data.

Figure 9-1: Boundary-Scan Register

This figure shows how test data is serially shifted around the periphery of the IEEE Std. 1149.1 device.



Boundary-Scan Cells of a Cyclone V Device I/O Pin

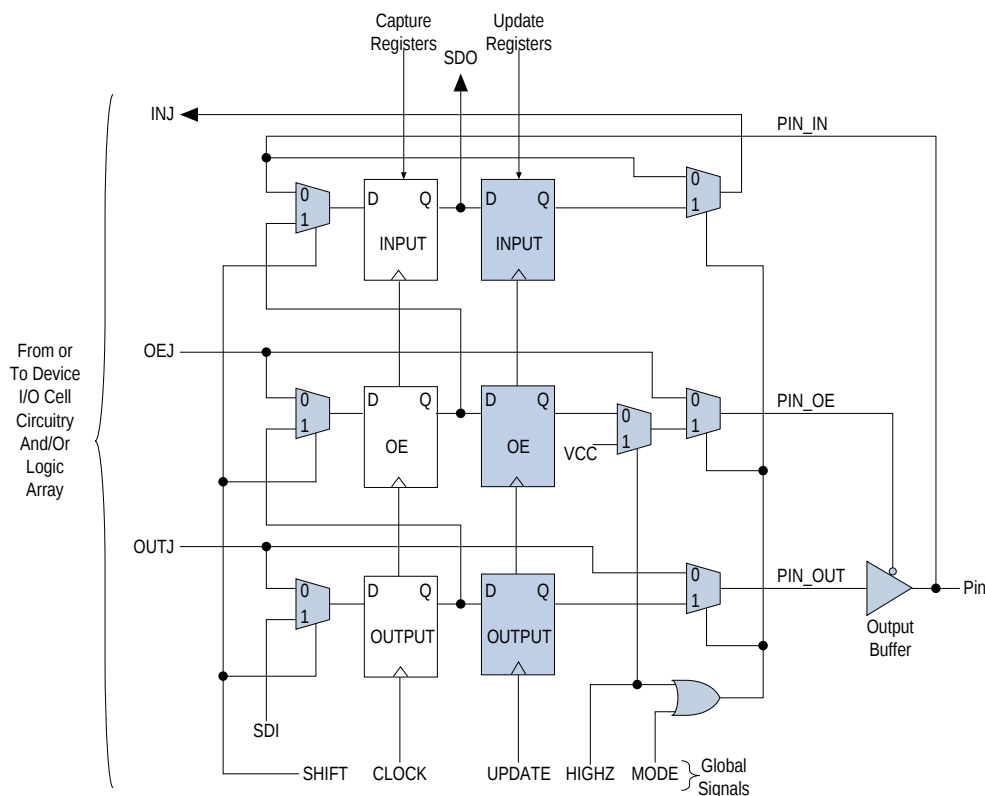
The Cyclone V device 3-bit BSC consists of the following registers:

- Capture registers—Connect to internal device data through the OUTJ, OEJ, and PIN_IN signals.
- Update registers—Connect to external data through the PIN_OUT and PIN_OE signals.

The TAP controller generates the global control signals for the IEEE Std. 1149.1 BST registers (`shift`, `clock`, and `update`) internally. A decode of the instruction register generates the `MODE` signal.

The data signal path for the boundary-scan register runs from the serial data in (SDI) signal to the serial data out (SDO) signal. The scan register begins at the TDI pin and ends at the TDO pin of the device.

Figure 9-2: User I/O BSC with IEEE Std. 1149.1 BST Circuitry for Cyclone V Devices



Note: TDI, TDO, TMS, and TCK pins, all VCC and GND pin types, and VREF pins do not have BSCs.

Table 9-5: Boundary-Scan Cell Descriptions for Cyclone V Devices

This table lists the capture and update register capabilities of all BSCs within Cyclone V devices.

Pin Type	Captures			Drives			Comments
	Output Capture Register	OE Capture Register	Input Capture Register	Output Update Register	OE Update Register	Input Update Register	
User I/O pins	OUTJ	OEJ	PIN_IN	PIN_OUT	PIN_OE	INJ	—
Dedicated clock input	0	1	PIN_IN	No Connect (N.C.)	N.C.	N.C.	PIN_IN drives to the clock network or logic array
Dedicated input ⁽²²⁾	0	1	PIN_IN	N.C.	N.C.	N.C.	PIN_IN drives to the control logic

⁽²²⁾ This includes the PLL_ENA, VCCSEL, PORSEL, nIO_PULLUP, nCONFIG, MSEL0, MSEL1, MSEL2, MSEL3, MSEL4, and nCE pins.

Pin Type	Captures			Drives			Comments
	Output Capture Register	OE Capture Register	Input Capture Register	Output Update Register	OE Update Register	Input Update Register	
Dedicated bidirectional (open drain) ⁽²³⁾	0	OEJ	PIN_IN	N.C.	N.C.	N.C.	PIN_IN drives to the configuration control
Dedicated bidirectional ⁽²⁴⁾	OUTJ	OEJ	PIN_IN	N.C.	N.C.	N.C.	PIN_IN drives to the configuration control and OUTJ drives to the output buffer
Dedicated output ⁽²⁵⁾	OUTJ	0	0	N.C.	N.C.	N.C.	OUTJ drives to the output buffer

Document Revision History

Date	Version	Changes
May 2013	2013.05.06	<ul style="list-style-type: none"> Added link to the known document issues in the Knowledge Base. Moved all links to the Related Information section of respective topics for easy reference.
December 2012	2012.12.28	Reorganized content and updated template.
June 2012	2.0	<ul style="list-style-type: none"> Restructured the chapter. Updated Table 9-1 and Table 9-2.
October 2011	1.0	Initial release.

⁽²³⁾ This includes the CONF_DONE and nSTATUS pins.

⁽²⁴⁾ This includes the DCLK pin.

⁽²⁵⁾ This includes the nCEO pin.

Power Management in Cyclone V Devices 10

2013.06.28

CV-52010



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This chapter describes the hot-socketing feature, power-on reset (POR) requirements, and their implementation in Cyclone V devices.

Related Information

- **Cyclone V Device Handbook: Known Issues**
Lists the planned updates to the *Cyclone V Device Handbook* chapters.
- **PowerPlay Power Analysis**
Provides more information about the Quartus®II PowerPlay Power Analyzer tool.
- **Cyclone V Device Datasheet**
Provides more information about the recommended operating conditions of each power supply.
- **Cyclone V Device Family Pin Connection Guidelines**
Provides detailed information about power supply pin connection guidelines and power regulator sharing.
- **Board Design Resource Center**
Provides detailed information about power supply design requirements.

Power Consumption

The total power consumption of a Cyclone V device consists of the following components:

- Static power—the power that the configured device consumes when powered up but no clocks are operating.
- Dynamic power—the additional power consumption of the device due to signal activity or toggling.

Dynamic Power Equation

Figure 10-1: Dynamic Power

The following equation shows how to calculate dynamic power where P is power, C is the load capacitance, and V is the supply voltage level.

$$P = \frac{1}{2} CV^2 \times frequency$$

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The equation shows that power is design-dependent and is determined by the operating frequency of your design. Cyclone V devices minimize static and dynamic power using advanced process optimizations. This technology allows Cyclone V designs to meet specific performance requirements with the lowest possible power.

Hot-Socketing Feature

Cyclone V devices support hot socketing—also known as hot plug-in or hot swap.

The hot-socketing circuitry monitors the V_{CCIO} , V_{CCPD} , and V_{CC} power supplies and all V_{CCIO} and V_{CCPD} banks.

You can power up or power down these power supplies in any sequence.

During the hot-socketing operation, the I/O pin capacitance is less than 15 pF and the clock pin capacitance is less than 20 pF.

The hot-socketing capability removes some of the difficulty that designers face when using the Cyclone V devices on PCBs that contain a mixture of devices with different voltage requirements.

The hot-socketing capability in Cyclone V devices provides the following advantages:

- You can drive signals into the I/O, dedicated input, and dedicated clock pins before or during power up or power down without damaging the device. External input signals to the I/O pins of the unpowered device will not power the power supplies through internal paths within the device.
- The output buffers are tri-stated during system power up or power down. Because the Cyclone V device does not drive signals out before or during power up, the device does not affect the other operating buses.
- You can insert or remove a Cyclone V device from a powered-up system board without damaging or interfering with the system board's operation. This capability allows you to avoid sinking current through the device signal pins to the device power supply, which can create a direct connection to GND that causes power supply failures.
- During hot socketing, Cyclone V devices are immune to latch up that can occur when a device is hot-socketed into an active system.

Altera uses GND as a reference for hot-socketing and I/O buffer circuitry designs. To ensure proper operation, connect GND between boards before connecting the power supplies. This prevents GND on your board from being pulled up inadvertently by a path to power through other components on your board. A pulled up GND could otherwise cause an out-of-specification I/O voltage or over current condition in the Altera device.

Related Information

[Cyclone V Device Datasheet](#)

Provides details about the Cyclone V hot-socketing specifications.

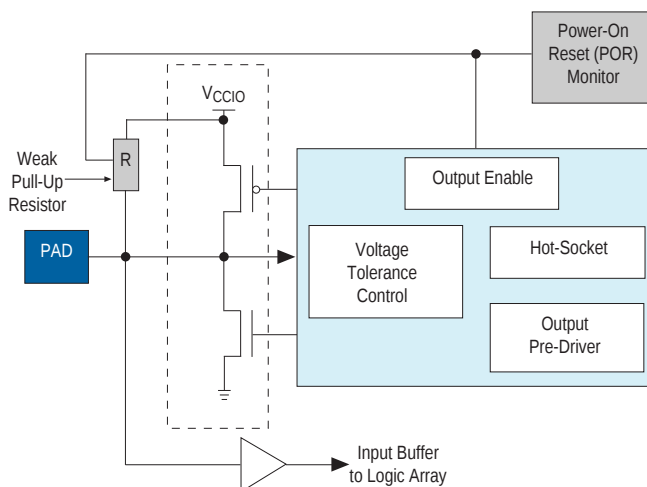
Hot-Socketing Implementation

The hot-socketing feature tri-state the output buffer during power up and power down of the power supplies. When these power supplies are below the threshold voltage, the hot-socketing circuitry generates an internal HOTSCKT signal.

Hot-socketing circuitry prevents excess I/O leakage during power up. When the voltage ramps up very slowly, I/O leakage is still relatively low, even after the release of the POR signal and configuration is complete.

Note: The output buffer cannot flip from the state set by the hot-socketing circuitry at very low voltage. To allow the CONF_DONE and nSTATUS pins to operate during configuration, the hot-socketing feature is not applied to these configuration pins. Therefore, these pins will drive out during power up and power down.

Figure 10-2: Hot-Socketing Circuitry for Cyclone V Devices



The POR circuitry monitors the voltage level of the power supplies and keeps the I/O pins tri-stated until the device is in user mode. The weak pull-up resistor (R) in the Cyclone V input/output element (IOE) is enabled during configuration download to keep the I/O pins from floating.

The 3.3-V tolerance control circuit allows the I/O pins to be driven by 3.3 V before the power supplies are powered and prevents the I/O pins from driving out before the device enters user mode.

Power-Up Sequence

To ensure the minimum current draw during device power up for Cyclone V devices, follow the power-up sequence recommendations as shown in the following figure.

Figure 10-3: Power-Up Sequence Recommendation for Cyclone V Devices

Power up V_{CCBAT} at any time. Ramp up the power rails in each group to a minimum of 80% of their full rail before the next group starts. Power up V_{CCE_GXB} and V_{CCL_GXB} together with V_{CC} .

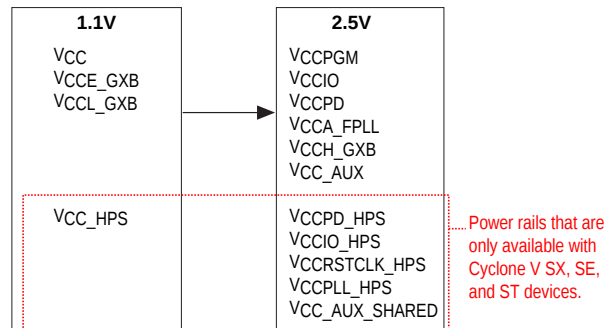


Table 10-1 lists the current transient that you may observe at the indicated power rails after powering up the Cyclone V device, and before configuration starts. These transients have a finite duration bounded by the time at which the device enters configuration mode. For Cyclone V SX, SE and ST devices, you may observe the current transient in **Table 10-1** after powering up the device, and before all the power supplies reach the recommended operating range.

Table 10-1: Maximum Power Supply Current Transient and Typical Duration

Power Rail	Maximum Power Supply Current Transient (mA)	Typical Duration (μ s)
$V_{CCPD}^{(26), (27)}$	1000	50
$V_{CCIO}^{(28), (27)}$	250	200
$V_{CC_AUX}^{(29)}$	400	10
$V_{CC}^{(29)}$	350	100
$V_{CCPD_HPS}^{(30), (31), (32)}$	400	50
$V_{CCIO_HPS}^{(30), (31), (32)}$	100	200
$V_{CC_HPS}^{(29), (30)}$	420	100

- ⁽²⁶⁾ You may observe the current transient at V_{CCPD} only when you do not follow the recommended power-up sequence. To avoid the current transient at V_{CCPD} , follow the recommended power-up sequence.
- ⁽²⁷⁾ The maximum current for V_{CCIO} and V_{CCPD} applies to all voltage levels supported by the Cyclone V device.
- ⁽²⁸⁾ You may observe the current transient at V_{CCIO} if you power up V_{CCIO} before V_{CCPD} . To avoid the current transient at V_{CCIO} , follow the recommended power-up sequence by powering up V_{CCIO} and V_{CCPD} together.
- ⁽²⁹⁾ You may observe the current transient at V_{CC_AUX} , V_{CC} , and V_{CC_HPS} with any power-up sequence.
- ⁽³⁰⁾ These power rails are only available on Cyclone V SX, SE and ST devices.
- ⁽³¹⁾ You may observe the current transient at V_{CCIO_HPS} if you power up V_{CCIO_HPS} before V_{CCPD_HPS} . To avoid the current transient at V_{CCIO_HPS} , follow the recommended power-up sequence by powering up V_{CCIO_HPS} and V_{CCPD_HPS} together.
- ⁽³²⁾ The maximum current for V_{CCIO_HPS} and V_{CCPD_HPS} applies to all voltage levels supported by the Cyclone V device.

For details about the minimum current requirements, refer to the PowerPlay Early Power Estimator (EPE), and compare to the information listed in [Table 10-1](#). If the current transient exceeds the minimum current requirements in the PowerPlay EPE, you need to take the information into consideration for your power regulator design.

Related Information

PowerPlay Early Power Estimators (EPE) and Power Analyzer

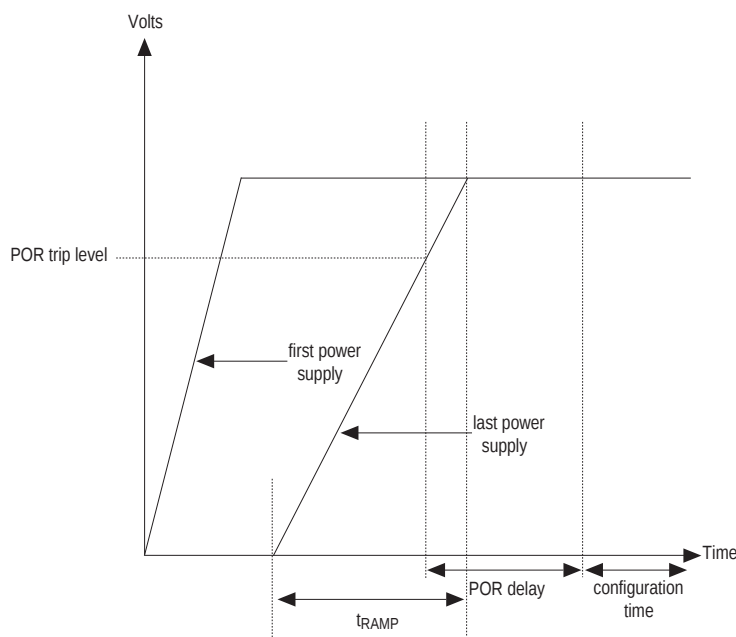
Provides more information about the PowerPlay EPE support for Cyclone V devices.

Power-On Reset Circuitry

The POR circuitry keeps the Cyclone V device in the reset state until the power supply outputs are within the recommended operating range.

A POR event occurs when you power up the Cyclone V device until the power supplies reach the recommended operating range within the maximum power supply ramp time, t_{RAMP} . If t_{RAMP} is not met, the Cyclone V device I/O pins and programming registers remain tri-stated, during which device configuration could fail.

Figure 10-4: Relationship Between t_{RAMP} and POR Delay

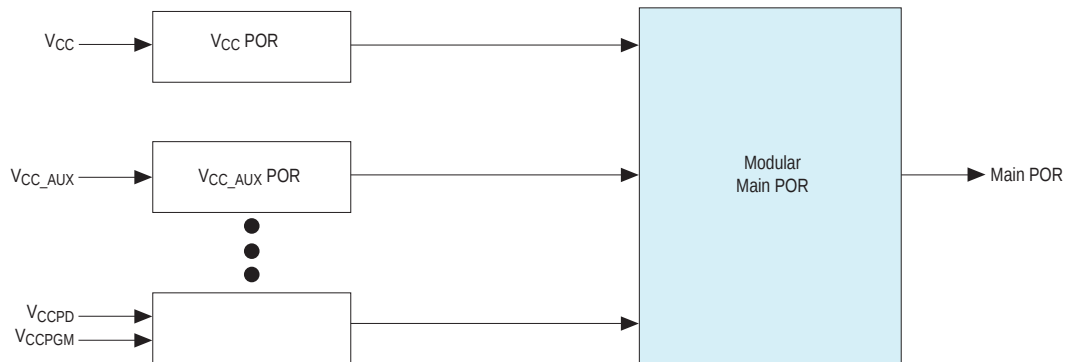


The Cyclone V POR circuitry uses an individual detecting circuitry to monitor each of the configuration-related power supplies independently. The main POR circuitry is gated by the outputs of all the individual detectors. The main POR signal is asserted when the power starts to ramp up. This signal is released after the last ramp-up power reaches the POR trip level during power up.

In user mode, the main POR signal is asserted when any of the monitored power goes below its POR trip level. Asserting the POR signal forces the device into the reset state.

The POR circuitry checks the functionality of the I/O level shifters powered by the V_{CCPD} and V_{CCPGM} power supplies during power-up mode. The main POR circuitry waits for all the individual POR circuitries to release the POR signal before allowing the control block to start programming the device.

Figure 10-5: Simplified POR Diagram for Cyclone V Devices



Related Information

[Cyclone V Device Datasheet](#)

Provides more information about the POR delay specification and t_{RAMP} .

Power Supplies Monitored and Not Monitored by the POR Circuitry

Table 10-2: Power Supplies Monitored and Not Monitored by the Cyclone V POR Circuitry

Power Supplies Monitored	Power Supplies Not Monitored
<ul style="list-style-type: none"> • V_{CC_AUX} • V_{CCBAT} • V_{CC} • V_{CCPD} • V_{CCPGM} • V_{CC_HPS} • V_{CCPD_HPS} • $V_{CCRSTCLK_HPS}$ 	<ul style="list-style-type: none"> • V_{CCE_GXBL} • V_{CCH_GXBL} • V_{CCL_GXBL} • V_{CCA_FPLL} • V_{CCIO} • V_{CCIO_HPS} • V_{CCPLL_HPS}

Note: For the device to exit POR, you must power the V_{CCBAT} power supply even if you do not use the volatile key.

Related Information

- [Reset Manager](#)
Provides information from the Hard Processor System Technical Reference Manual.
- [Configuration, Design Security, and Remote System Upgrades in Cyclone V Devices](#)
Provides more information about the MSEL pin settings for each POR delay.

Document Revision History

Date	Version	Changes
June 2013	2013.06.28	<ul style="list-style-type: none">Added power-up sequences for Cyclone V SX, SE and ST devices.Added the current transient that occurs on HPS power rails during power-up
May 2013	2013.05.06	<ul style="list-style-type: none">Added link to the known document issues in the Knowledge Base.Moved all links to the Related Information section of respective topics for easy reference.Updated dynamic power in Power Consumption for improve clarity.
December 2012	2012.12.28	<ul style="list-style-type: none">Added the Power-Up Sequence section.Reorganized content and updated template.
June 2012	2.0	Restructured the chapter.
October 2011	1.0	Initial release.

Cyclone V Device Handbook

Volume 2: Transceivers

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Transceiver Architecture in Cyclone V Devices

1

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Describes the Cyclone[®] V transceiver architecture, clocking, channels, channel bonding, and transmitter and receiver channel datapaths.

Altera[®] 28-nm Cyclone V devices provide transceivers with the lowest power requirement at 3.125 and 6.144 Gigabits per second (Gbps). These transceivers comply with a wide range of protocols and data rate standards; however, 6.144 Gbps support is limited to the common public radio interface (CPRI) protocol only.

Cyclone V devices have up to 12 transceiver channels with serial data rates between 614 megabits per second (Mbps) and 6.144 Gbps and have backplane-capable transceiver support for PCI Express[®] (PCIe[®]) Base Specification 2.0 Gen1 and Gen2 up to x4 bonded channels.

Cyclone V transceiver channels are full-duplex and clock data recovery (CDR)–based with physical coding sublayer (PCS) and physical medium attachment (PMA) layers.

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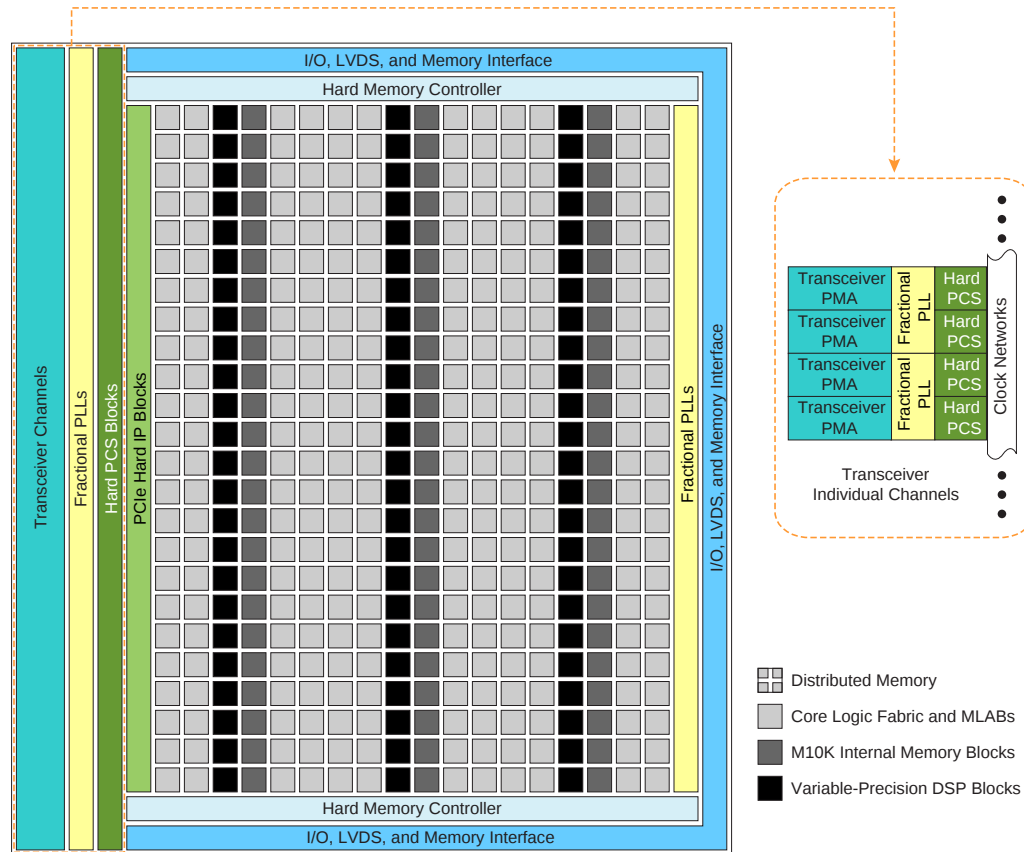
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Architecture Overview

Figure 1-1: Basic Layout of Transceivers in a Cyclone V Device

This figure represents a Cyclone V device with transceivers. Other Cyclone V devices may have a different floor plan than the one shown here.



The embedded high-speed clock networks in Cyclone V devices provide dedicated clocking connectivity for the transceivers. You can also use the fractional phase-locked loop (fPLL) between the PMA and PCS to clock the transceivers.

The embedded PCIe hard intellectual property (IP) of Cyclone V devices implements the following PCIe protocol stacks:

- Physical interface/media access control (PHY/MAC) layer
- Data link layer
- Transaction layer

The embedded hard IP saves significant FPGA resources, reduces design risks, and reduces the time required to achieve timing closure. The hard IP complies with the PCIe Base Specification 2.0 for Gen1 and Gen2 signaling data rates.

Related Information

- [Transceiver Clocking in Cyclone V Devices](#)

- [IP Compiler for PCI Express User Guide](#)
- [Cyclone V Device Handbook: Known Issues](#)
Lists the planned updates to the *Cyclone V Device Handbook* chapters.

Transceiver Banks

Cyclone V transceivers are grouped in transceiver banks of three channels. Some Cyclone V devices support four or five transceiver channels.

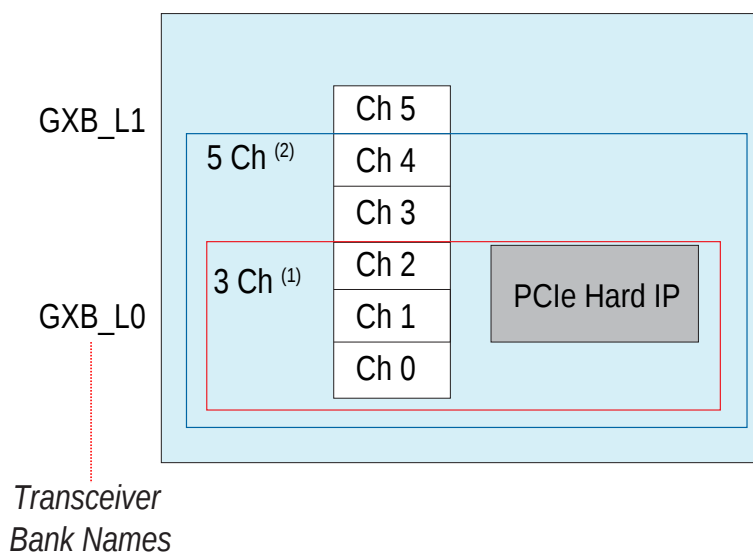
Every transceiver bank is comprised of three channels (ch 0, ch 1, and ch 2, or ch 3, ch 4, and ch 5). The Cyclone V device family has a total of four transceiver banks (for the largest density family) namely, GXB_L0, GXB_L1, GXB_L2 and GXB_L3.

The location of the transceiver bank boundaries are important for clocking resources, bonding channels, and fitting.

In some package variations, the total transceiver count is reduced.

Figure 1-2: GX/GT Devices with Three or Five Transceiver Channels and One PCIe HIP Block

The PCIe HIP block is located across Ch 1 and Ch 2 of banks GXB_L0.

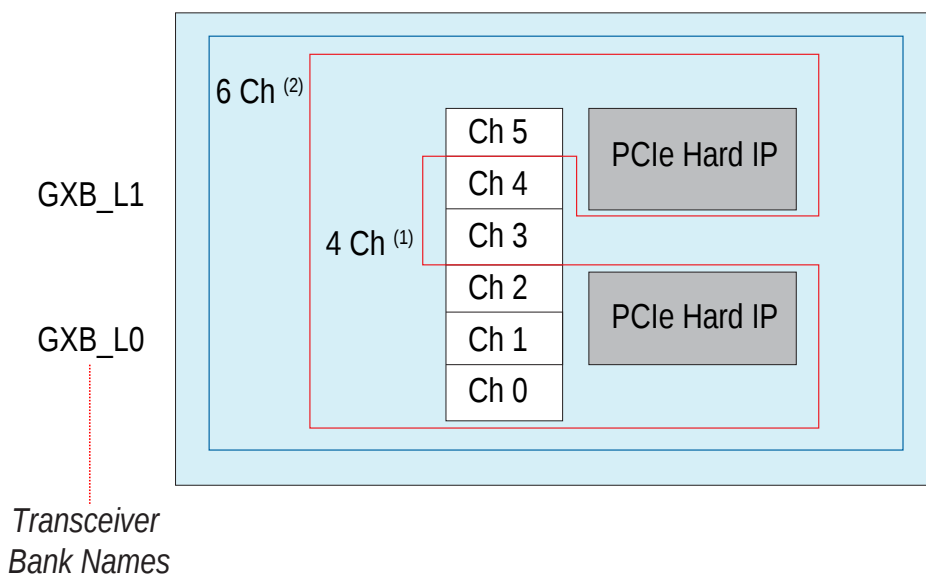


Notes:

1. 3-channel device transceiver channels are located on bank L0.
2. 5-channel device transceiver channels are located on bank L0, and Ch 3 and Ch 4 of bank L1.

Figure 1-3: GX/GT Devices with Four or Six Transceiver Channels and Two PCIe HIP Blocks

The PCIe HIP blocks are located across Ch 1 and Ch 2 of bank GXB_L0, and Ch 4 and Ch 5 of bank GXB_L1.

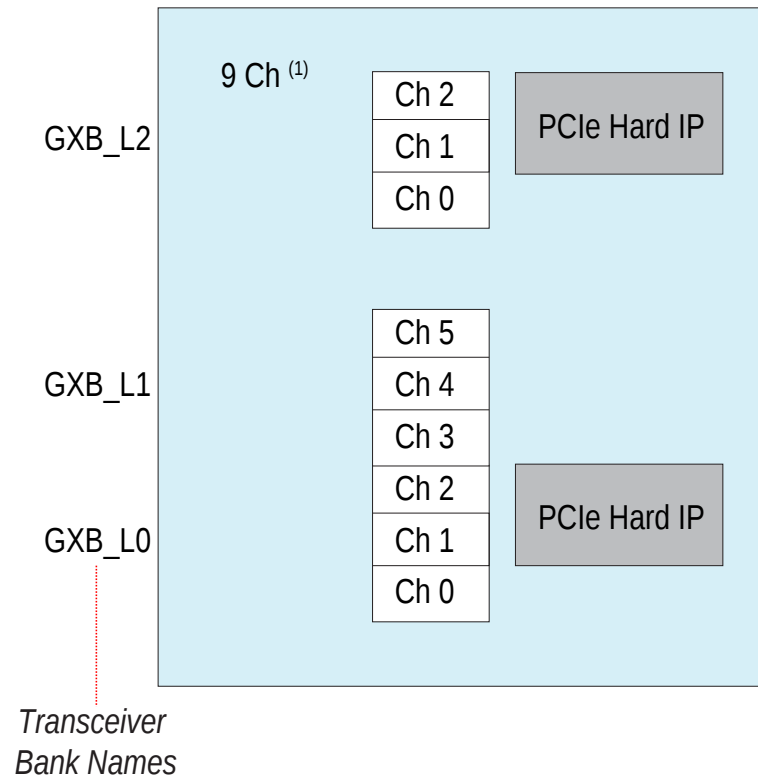


Notes:

1. 4-channel device transceiver channels are located on bank L0, and Ch 5 of bank L1.
2. 6-channel device transceiver channels are located on banks L0 and L1.

Figure 1-4: GX/GT/SX/ST Devices with Nine Transceiver Channels and Two PCIe HIP Blocks

The PCIe HIP blocks are located across Ch 1 and Ch 2 of bank GXB_L0, and Ch 1 and Ch 2 of bank GXB_L2.

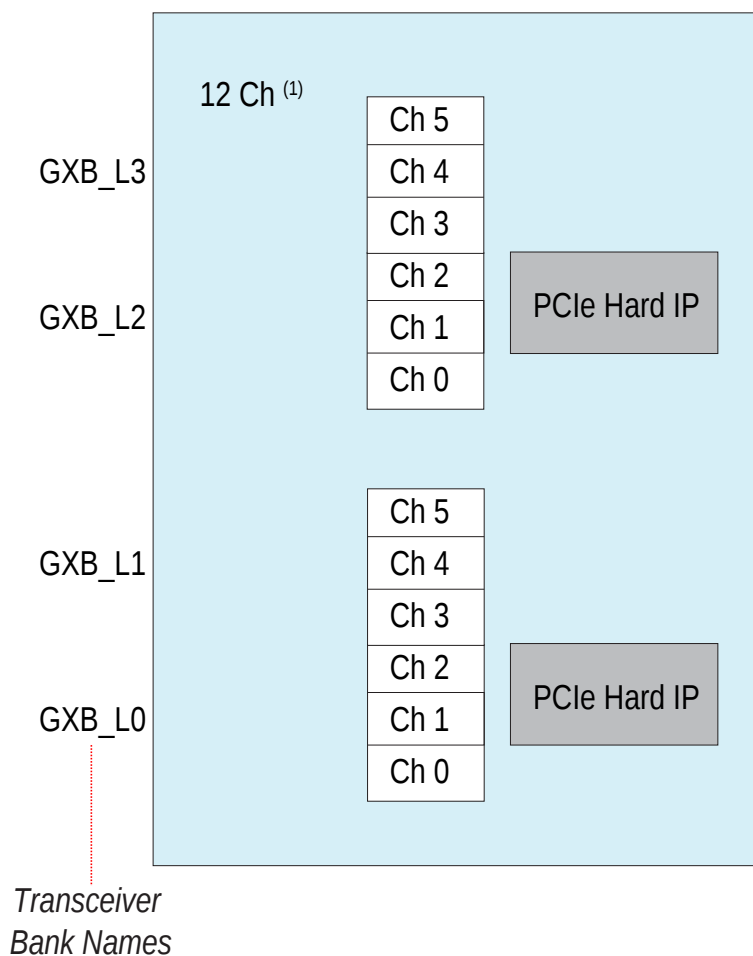


Note:

1. 9-channel device transceiver channels are located on banks L0, L1, and L2.

Figure 1-5: GX/GT Devices with 12 Transceiver Channels and Two PCIe HIP Blocks

The PCIe HIP blocks are located across Ch 1 and Ch 2 of bank GXB_L0, and Ch 1 and Ch 2 of bank GXB_L2.

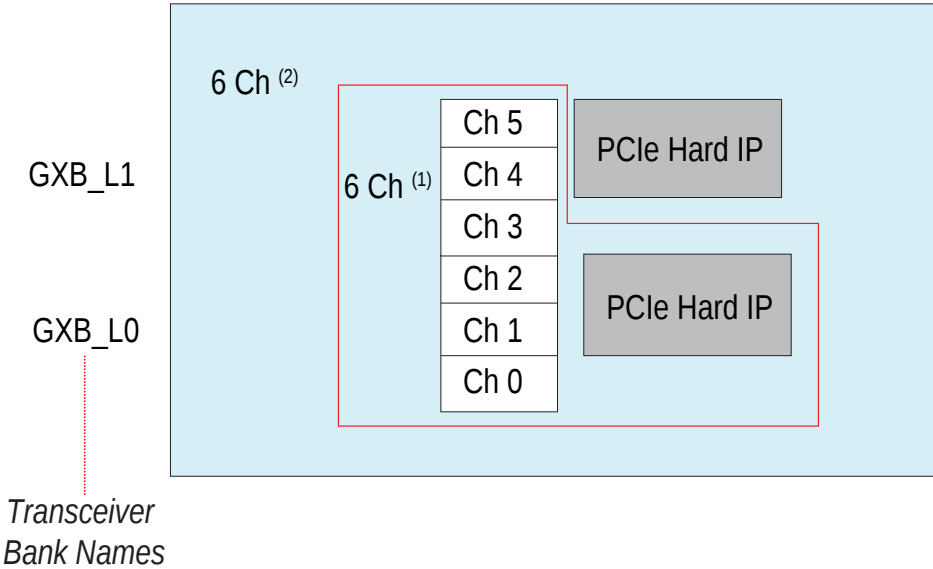


Note:

1. 12-channel device transceiver channels are located on banks L0, L1, L2, and L3.

Figure 1-6: SX Device with Six Transceiver Channels and One or Two PCIe HIP Blocks

The PCIe HIP blocks are located across Ch 1 and Ch 2 of bank GXB_L0, and Ch 4 and Ch 5 of bank GXB_L1.



- Notes:
- 1. 6 transceiver channels with one PCIe HIP block.
 - 2. 6 transceiver channels with two PCIe HIP blocks.

Usage Restrictions on Specific Channels

Channels next to PCIe Hard IP block are not timing-optimized for the 6.144 Gbps CPRI data rate. Avoid placing the 6.144 Gbps CPRI channels in affected channels. The affected channels can still be used as a CMU to clock the CPRI channels.

Table 1-1: Usage Restrictions on Specific Channels Across Device Variants

Channels	Channel Bank Location	Usage Restriction
Ch 1, Ch 2	GXB_L0	<ul style="list-style-type: none">No 6.144 Gbps CPRI supportNo support for PCS with phase compensation FIFO in registered mode
Ch 4, Ch 5	GXB_L1 ⁽¹⁾	
Ch 1, Ch 2	GXB_L2 ⁽¹⁾	

Cyclone V GX transceiver channels are comprised of a transmitter and receiver that can operate individually and simultaneously—providing a full-duplex physical layer implementation for high-speed serial interfacing.

⁽¹⁾ Impacted only if the device has PCIe HIP block located next to this bank.

The transmitter and receiver in a channel are structured into PMA and PCS sections:

- PMA—converts serial data to parallel data and vice versa for connecting the FPGA to a serial transmission medium.
- PCS—prepares the parallel data for transmission across a physical medium or restores the data to its original form using hard digital logic implementation.

6.144 Gbps CPRI Support Capability in GT Devices

You can configure Cyclone V GT devices to support 6.144 Gbps for CPRI protocol only. The Cyclone V GT device supports up to three full duplex channels that are compliant to the 6.144 Gbps CPRI protocol for every two transceiver banks. The transceivers are grouped in transceiver banks of three channels.

Altera recommends that you increase the VCCE_GXBL and VCCL_GXBL to a nominal value of 1.2 V in order to be compliant to the 6.144Gbps CPRI protocol. The reference clock frequency for the 6.144 Gbps CPRI channel must be ≥ 307.2 MHz.

Related Information

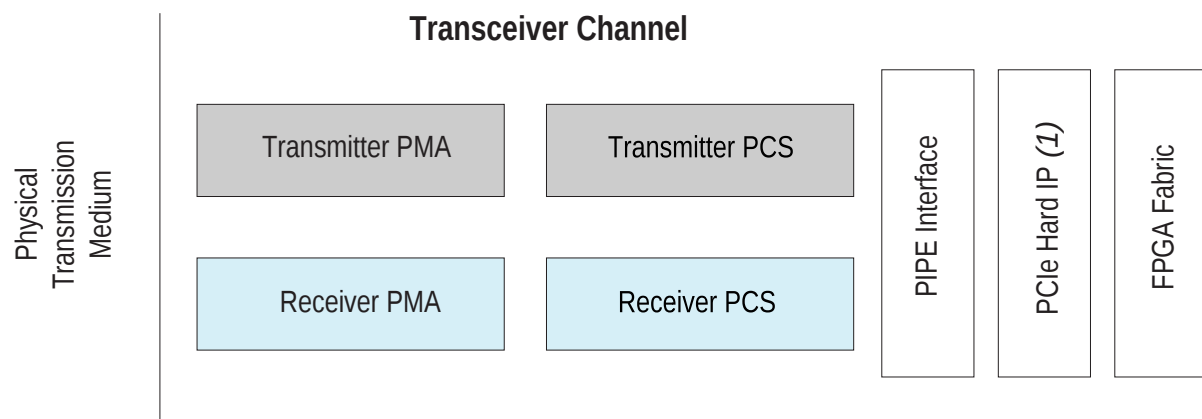
[Transceiver Protocol Configurations in Cyclone V Devices](#)

Transceiver Channel Architecture

Cyclone V transceiver channels support the following interface methods with the FPGA fabric:

- Directly—bypassing the PIPE interface for the PCIe interface and PCIe hard IP block
- Through the PIPE interface and PCIe hard IP block—for hard IP implementation of the PCIe protocol stacks (PHY/MAC, data link layer, and transaction layer)

Figure 1-7: Transceiver Channel Block Diagram in Cyclone V Devices



Note:

1. Only certain transceiver channels support interfacing to the PCIe hard IP block.

You can bond multiple channels to implement a multilane link.

Related Information

[Transceiver Banks](#) on page 1-3

PMA Architecture

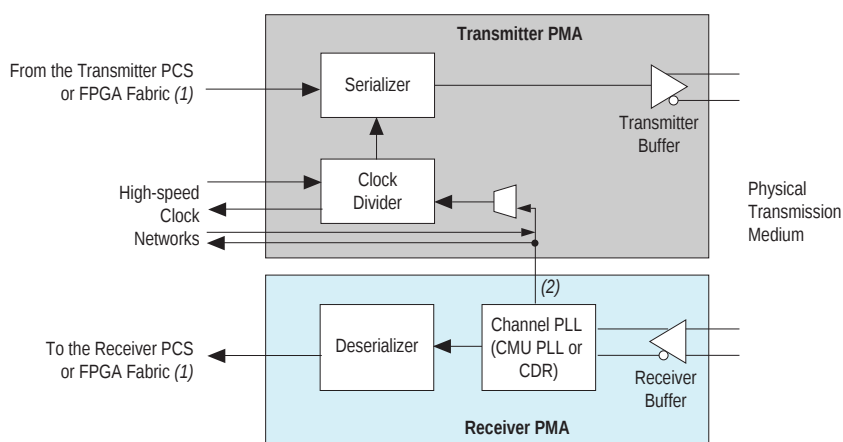
The PMA includes the transmitter and receiver datapaths, clock multiplier unit (CMU) PLL—configured from the channel PLL—and the clock divider. The analog circuitry and differential on-chip termination (OCT) in the PMA requires the calibration block to compensate for process, voltage, and temperature variations (PVT).

Each transmitter channel has a clock divider. There are two types of clock dividers, depending on the channel location in a transceiver bank:

- Channels 0, 2, 3, and 5—local clock divider
- Channels 1 and 4—central clock divider

Using clocks from the clock lines and CMU PLL, the clock divider generates the parallel and serial clock sources for transmitter and optionally for the receiver PCS. The central clock divider can additionally feed the clock lines used to bond channels compared to the local clock divider.

Figure 1-8: PMA Block Diagram of a Transceiver Channel in Cyclone V Devices



Related Information

- [Altera Transceiver PHY IP Core User Guide](#)
- [IP Compiler for PCI Express User Guide](#)

Transmitter PMA Datapath

Table 1-2: Functional Blocks in the Transmitter PMA Datapath

Block	Functionality
Serializer	<ul style="list-style-type: none"> Converts the incoming low-speed parallel data from the transmitter PCS to high-speed serial data and sends the data LSB first to the transmitter buffer. Supports 8-, 10-, 16-, and 20-bit serialization factors. Supports the optional polarity inversion and bit reversal features.
Transmitter Buffer	<ul style="list-style-type: none"> The 1.5-V PCML output buffer conditions the high-speed serial data for transmission into the physical medium. Programmable differential output voltage (VOD) Programmable pre-emphasis Programmable V_{CM} current strength Programmable slew rate On-chip biasing for common-mode voltage (TX V_{CM}) Differential OCT (85, 100, 120, and 150 Ω) Transmitter output tristate Receiver detect (for the PCIe receiver detection function)

Related Information

[Transmitter Buffer Features and Capabilities](#) on page 1-13

Serializer

The serializer converts the incoming low-speed parallel data from the transceiver PCS to high-speed serial data and sends the data to the transmitter buffer.

The serializer supports 8, 10, 16, and 20 bits of serialization factors. The serializer block sends out the LSB of the input data first. The transmitter serializer also has polarity inversion and bit reversal capabilities.

Transmitter Polarity Inversion

The positive and negative signals of a serial differential link might accidentally be swapped during board layout. The transmitter polarity inversion feature is provided to correct this situation without requiring a board re-spin or major updates to the logic in the FPGA fabric.

A high value on the `tx_invpolarity` port inverts the polarity of every bit of the input data word to the serializer in the transmitter datapath. Because inverting the polarity of each bit has the same effect as swapping the positive and negative signals of the differential link, correct data is sent to the receiver. The dynamic `tx_invpolarity` signal might cause initial disparity errors at the receiver of an 8B/10B encoded link. The downstream system must be able to tolerate these disparity errors.

Caution: If the polarity inversion is asserted midway through a serializer word, the word will be corrupted.

Bit Reversal

You can reverse the transmission bit order to achieve MSB-to-LSB ordering using the bit reversal feature at the transmitter.

Table 1-3: Bit Reversal Feature

Bit Reversal Option	Transmission Bit Order	
	8- or 10-bit Serialization Factor	16- or 20-bit Serialization Factor
Disabled (default)	LSB to MSB	LSB to MSB
Enabled	MSB to LSB For example: 8-bit—D[7 : 0] rewired to D[0 : 7] 10-bit—D[9 : 0] rewired to D[0 : 9]	MSB to LSB For example: 16-bit—D[15 : 0] rewired to D[0 : 15] 20-bit—D[19 : 0] rewired to D[0 : 19]

Transmitter Buffer

Transmitter buffers support the programmable analog settings (differential output voltage and pre-emphasis), common-mode voltage (TX V_{CM}), and OCT.

The transmitter buffer includes additional circuitry to improve integrity, such as the programmable differential output voltage (VOD), programmable three-tap pre-emphasis circuitry, internal termination circuitry, and PCIe receiver detect capability to support a PCIe configuration.

Modifying programmable values withing transmitter output buffers can be performed by a single reconfiguration controller for the entire FPGA, or multiple reconfiguration controllers if desired. Within each transceiver bank (three-transceiver channels), a maximum of one reconfiguration controller is allowed. There is only one slave interface to all PLLs and PMAs within each transceiver bank. Therefore, many transceiver banks can be connected to a single reconfiguration controller, but only one reconfiguration controller can be connected to the transceiver bank (three-transceiver channels).

Note: A maximum of one reconfiguration controller is allowed per transceiver bank.

Figure 1-9: Transmitter Buffer Block Diagram in Cyclone V Devices

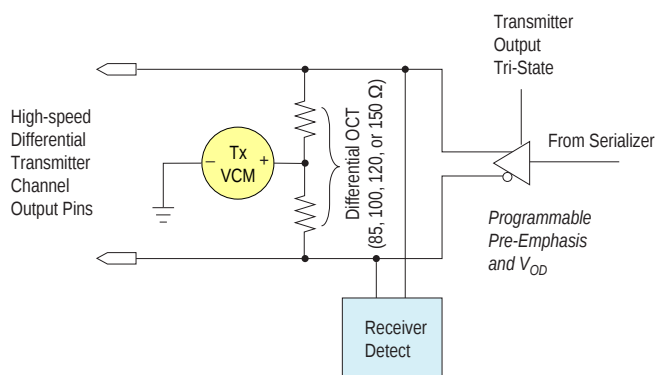


Table 1-4: Description of the Transmitter Buffer Features

Features provided by the Pseudo Current Mode Logic (PCML) output buffer to the integrated circuitry.

Category	Features	Description
Improve Signal Integrity	Programmable Differential Output Voltage (V_{OD})	Controls the current mode drivers for signal amplitude to handle different trace lengths, various backplanes, and receiver requirements. The actual V_{OD} level is a function of the current setting and the transmitter termination value.
	Programmable Pre-Emphasis	Boosts the high-frequency components of the transmitted signal, which may be attenuated when propagating through the transmission medium. The physical transmission medium can be represented as a low-pass filter in the frequency domain. Variation in the signal frequency response that is caused by attenuation significantly increases the data-dependent jitter and other intersymbol interference (ISI) effects at the receiver end. Use the pre-emphasis feature to maximize the data opening at the far-end receiver.
	Programmable Slew Rate	Controls the rate of change for the signal transition.
Save Board Space and Cost	On-Chip Biasing	Establishes the required transmitter common-mode voltage ($TX V_{CM}$) level at the transmitter output. The circuitry is available only if you enable OCT. When you disable OCT, you must implement off-chip biasing circuitry to establish the required $TX V_{CM}$ level.
	Differential OCT	The termination resistance is adjusted by the calibration circuitry, which compensates for PVT. You can disable OCT and use external termination. However, you must implement off-chip biasing circuitry to establish the required $TX V_{CM}$ level. $TX V_{CM}$ is tri-stated when you use external termination.
Reduce Power	Programmable V_{CM} Current Strength	Controls the impedance of V_{CM} . A higher impedance setting reduces current consumption from the on-chip biasing circuitry.

Category	Features	Description
Protocol-Specific Function	Transmitter Output Tri-State	Enables the transmitter differential pair voltages to be held constant at the same value determined by the TX V_{CM} level with the transmitter in the high impedance state. This feature is compliant with differential and common-mode voltage levels and operation time requirements for transmitter electrical idle, as specified in the PCI Express Base Specification 2.0 for Gen1 and Gen2 signaling rates.
	Receiver Detect	Provides link partner detection capability at the transmitter end using an analog mechanism for the receiver detection sequence during link initialization in the Detect state of the PCIe Link Training and Status State Machine (LTSSM) states. The circuit detects if there is a receiver downstream by changing the transmitter common-mode voltage to create a step voltage and measuring the resulting voltage rise time. For proper functionality, the series capacitor (AC-coupled link) and receiver termination values must comply with the PCI Express Base Specification 2.0 for Gen1 and Gen2 signaling rates. The circuit is clocked using <code>fixedclk</code> and requires an enabled transmitter OCT with the output tri-stated.

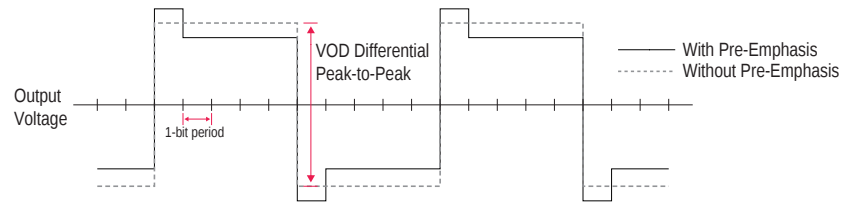
Transmitter Buffer Features and Capabilities

Table 1-5: Transmitter Buffer Features

Feature	Capability
Programmable Differential Output Voltage (V_{OD})	Up to 1200 mV of differential peak-to-peak output voltage
Programmable Pre-Emphasis	Support first Updated the Post Tap Pre-emphasis setting
On-Chip Biasing for Common-Mode Voltage (TX V_{CM})	0.65 V
Differential OCT	85, 100, 120, and 150 Ω
Transmitter Output Tri-State	Supports the electrical idle function at the transmitter as required by the PCIe Base Specification 2.0 for Gen1 and Gen2 signaling rates
Receiver Detect	Supports the receiver detection function as required by the PCIe Base Specification 2.0 for Gen1 and Gen2 signaling rates

Figure 1-10: Example of the Pre-Emphasis Effect on Signal Transmission at the Transmitter Output

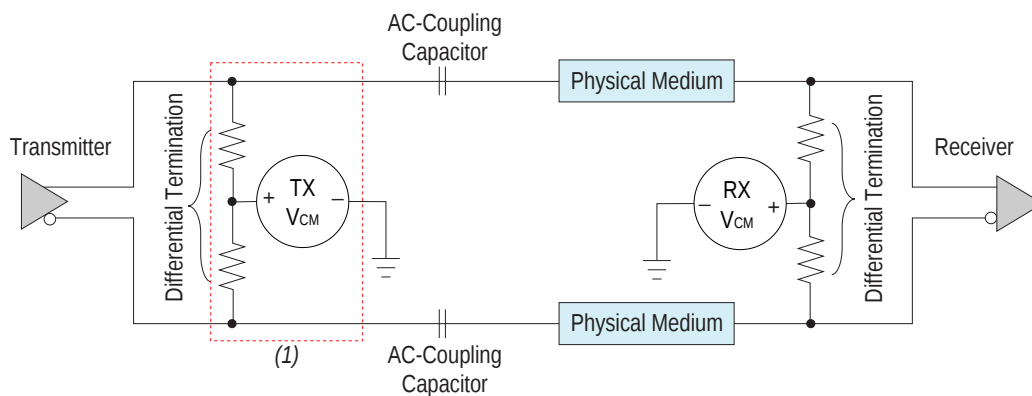
Signal transmission at the transmitter output with and without applying pre-emphasis post-tap for a 3.125 Gbps signal with an alternating data pattern of five 1s and five 0s.



You can AC-couple the transmitter to a receiver. In an AC-coupled link, the AC-coupling capacitor blocks the transmitter common-mode voltage. At the receiver end, the termination and biasing circuitry restores the common-mode voltage level that is required by the receiver.

Figure 1-11: AC-Coupled Link with a Cyclone V Transmitter

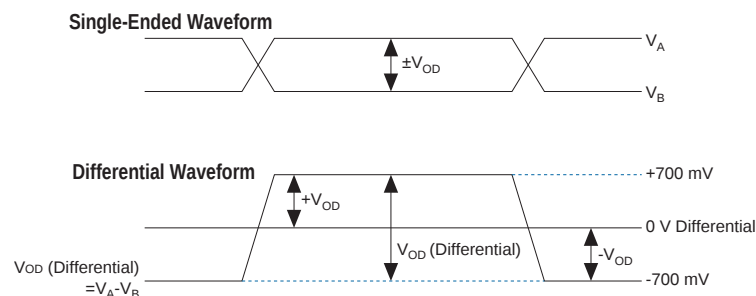
The PCIe spec requires that you enable transmitter OCT for receiver detect operation.



Notes:

1. When you disable OCT, you must implement external termination and off-chip biasing circuitry to establish the required TX V_{CM} level.

Programmable Transmitter Analog Settings

Figure 1-12: V_{OD} (Differential) Signal Level

Each transmit buffer has programmable pre-emphasis circuits that boost high frequencies in the transmit data signal, which might be attenuated in the transmission media. Using pre-emphasis can maximize the

data eye opening at the far-end receiver. The pre-emphasis circuitry provides first post-tap settings with up to 6 dB of high-frequency boost.

Programmable Transmitter V_{CM}

The transmitter buffers have on-chip biasing circuitry to establish the required V_{CM} at the transmitter output. The circuitry supports a V_{CM} setting of 0.65 V.

Note: On-chip biasing circuitry is available only if you select one of the Termination logic options in order to configure OCT. If you select external termination, you must implement off-chip biasing circuitry to establish the V_{CM} at the transmitter output buffer.

Programmable Transmitter Differential OCT

The transmitter buffers support optional differential OCT resistances of 85, 100, 120, and 150 Ω . The resistance is adjusted by the on-chip calibration circuit during calibration, which compensates for PVT changes. The transmitter buffers are current mode drivers. Therefore, the resultant V_{OD} is a function of the transmitter termination value.

Transmitter Protocol Specific

There are two PCIe features in the transmitter PMA section—receiver detect and electrical idle.

- PCIe Receiver Detect—The transmitter buffers have a built-in receiver detection circuit for use in PCIe configurations for Gen1 and Gen2 data rates. This circuit detects whether there is a receiver downstream by sending out a pulse on the common mode of the transmitter and monitoring the reflection.
- PCIe Electrical Idle—The transmitter output buffers support transmission of PCIe electrical idle (or individual transmitter tri-state).

Related Information

[Altera Transceiver PHY IP Core User Guide](#)

Receiver PMA Datapath

There are three blocks in the receiver PMA datapath—the receiver buffer, channel PLL configured for clock data recovery (CDR) operation, and deserializer.

Table 1-6: Functional Blocks in the Receiver PMA Datapath

Block	Functionality
Receiver Buffer	<ul style="list-style-type: none">• Receives the serial data stream and feeds the stream to the channel PLL if you configure the channel PLL as a CDR• Supports the following features:<ul style="list-style-type: none">• Programmable CTLE (Continuous Time Linear Equalization)• Programmable DC gain• Programmable V_{CM} current strength• On-chip biasing for common-mode voltage (RX V_{CM})• I/O standard (1.5 V PCML, 2.5 V PCML, LVDS, LVPECL)• Differential OCT (85, 100, 120 and 150 Ω)• Signal detect

Block	Functionality
Channel PLL	<ul style="list-style-type: none"> Recovers the clock and serial data stream if you configure the channel PLL as a CDR. Requires offset cancellation to correct the analog offset voltages. If you do not use the channel PLL as a CDR, you can configure the channel PLL as a CMU PLL for clocking the transceivers.
Deserializer	<ul style="list-style-type: none"> Converts the incoming high-speed serial data from the receiver buffer to low-speed parallel data for the receiver PCS. Receives serial data in LSB-to-MSB order. Supports 8-, 10-, 16-, and 20-bit deserialization factors. Supports the optional clock-slip feature for applications with stringent latency uncertainty requirement.

Receiver Buffer

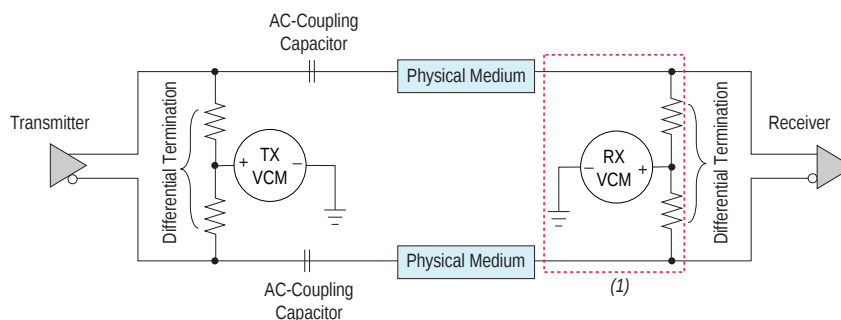
Table 1-7: Cyclone Receiver Buffer Features

Category	Features	Description
Improve Signal Integrity	Programmable Continuous Time Linear Equalization (CTLE)	Boosts the high-frequency components of the received signal, which may be attenuated when propagating through the transmission medium. The physical transmission medium can be represented as a low-pass filter in the frequency domain. Variation in the signal frequency response that is caused by attenuation leads to data-dependent jitter and other ISI effects—causing incorrect sampling on the input data at the receiver. The amount of the high-frequency boost required at the receiver to overcome signal attenuation depends on the loss characteristics of the physical medium.
	Programmable DC Gain	Provides equal boost to the received signal across the frequency spectrum.
Save Board Space and Cost	On-Chip Biasing	Establishes the required receiver common-mode voltage ($RX V_{CM}$) level at the receiver input. The circuitry is available only if you enable OCT. When you disable OCT, you must implement off-chip biasing circuitry to establish the required $RX V_{CM}$ level.
	Differential OCT	The termination resistance is adjusted by the calibration circuitry, which compensates for PVT. You can disable OCT and use external termination. However, you must implement off-chip biasing circuitry to establish the required $RX V_{CM}$ level. $RX V_{CM}$ is tri-stated when you use external termination.
Reduce Power	Programmable V_{CM} Current Strength	Controls the impedance of V_{CM} . A higher impedance setting reduces current consumption from the on-chip biasing circuitry.

Category	Features	Description
Protocol-Specific Function	Signal Detect	<p>Senses if the signal level present at the receiver input is above or below the threshold voltage that you specified. The detection circuitry has a hysteresis response that asserts the status signal only when a number of data pulses exceeding the threshold voltage are detected and deasserts the status signal when the signal level below the threshold voltage is detected for a number of recovered parallel clock cycles. The circuitry requires the input data stream to be 8B/10B-coded.</p> <p>Signal detect is compliant to the threshold voltage and detection time requirements for electrical idle detection conditions as specified in the PCI Express Base Specification 2.0 for Gen1 and Gen2 signaling rates. Signal detect is also compliant to SATA/SAS protocol up to 3 Gbps support.</p>

You can AC-couple the receiver to a transmitter. In an AC-coupled link, the AC-coupling capacitor blocks the transmitter common-mode voltage. At the receiver end, the termination and biasing circuitry restores the common-mode voltage level that is required by the receiver.

Figure 1-13: AC-Coupled Link with a Cyclone V Receiver

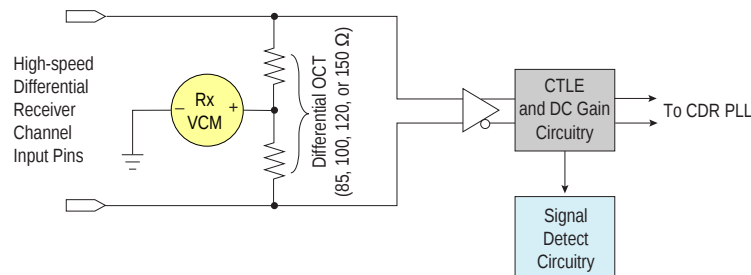


Note:

1. When you disable OCT, you must implement external termination and off-chip biasing circuitry to establish the required $RX V_{CM}$ level.

The receiver buffers support the programmable analog settings (CTLE and DC gain), programmable common mode voltage ($RX V_{CM}$), OCT, and signal detect function.

The receiver input buffer receives serial data from the high-speed differential receiver channel input pins and feeds the serial data to the channel PLL configured as a CDR unit.

Figure 1-14: Receiver Buffer Block Diagram in Cyclone V Devices

Modifying programmable values within receiver input buffers can be performed by a single reconfiguration controller for the entire FPGA, or multiple reconfiguration controllers if desired. Within each transceiver bank (three-transceiver channels) a maximum of one reconfiguration controller is allowed. There is only one slave interface to all PLLs and PMAs within each transceiver bank. Therefore, many transceiver banks can be connected to a single reconfiguration controller, but only one reconfiguration controller can be connected to the transceiver bank (three-transceiver channels).

Note: A maximum of one reconfiguration controller is allowed per transceiver bank.

Programmable CTLE and DC Gain

Each receiver buffer has a single-tap programmable equalization circuit that boosts the high-frequency gain of the incoming signal, thereby compensating for the low-pass filter effects of the physical medium. The amount of high-frequency gain required depends on the loss characteristics of the physical medium. The equalization circuitry provides up to 4 dB of high-frequency boost.

Each receiver buffer also supports the programmable DC gain circuitry that provides an equal boost to the incoming signal across the frequency spectrum. The DC gain circuitry provides up to 3 dB of gain setting.

Programmable Receiver V_{CM}

The receiver buffers have on-chip biasing circuitry to establish the required V_{CM} at the receiver input. The circuitry supports a V_{CM} setting of 0.8 V.

On-chip biasing circuitry is available only if you select one of the termination logic options in order to configure OCT. If you select external termination, you must implement off-chip biasing circuitry to establish V_{CM} at the receiver input buffer.

Programmable Receiver Differential On-Chip Termination

The receiver buffers support optional differential OCT resistances of 85, 100, 120, and 150 Ω . The resistance is adjusted by the on-chip calibration circuit during calibration, which compensates for PVT changes.

Signal Threshold Detection Circuitry

In a PCIe and SATA/SAS configuration, the signal threshold detection circuitry will be enabled to detect the present of incoming signal.

The signal threshold detection circuitry senses whether the signal level present at the receiver input buffer is above the signal detect threshold voltage you specified.

Deserializer

The deserializer block clocks in serial input data from the receiver buffer using the high-speed serial recovered clock and deserializes the data using the low-speed parallel recovered clock. The deserializer forwards the deserialized data to the receiver PCS.

The deserializer supports 8, 10, 16, and 20 bits of deserialization factors.

Figure 1-15: Deserializer Operation with a 10-bit Deserialization Factor

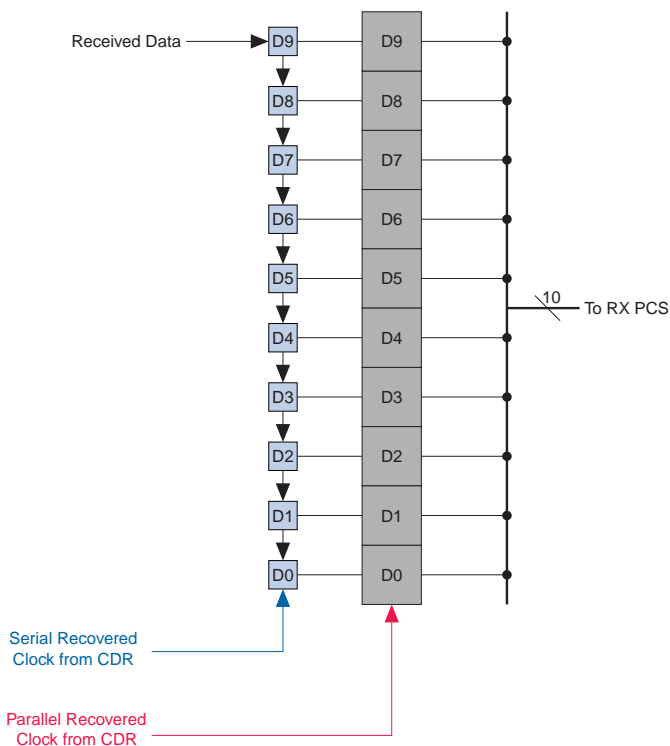
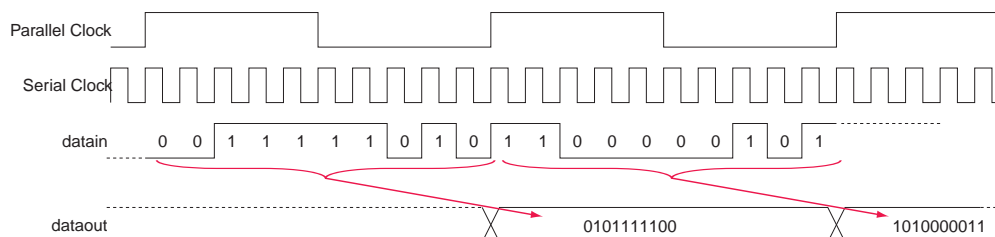


Figure 1-16: Deserializer Bit Order with 10-bit Deserialization Factor

The serial stream (0101111100) is deserialized to a 10'h17C value. The serial data is received LSB to MSB.



Clock-slip

Word alignment in the PCS may contribute up to one parallel clock cycle of latency uncertainty. The clock-slip feature allows word alignment operation with a reduced latency uncertainty by performing the word alignment function in the deserializer. Use the clock slip feature for applications that require deterministic latency.

The deterministic latency state machine in the word aligner from the PCS automatically controls the clock-slip operation. After completing the clock-slip process, the deserialized data is word-aligned into the receiver PCS.

Transmitter PLL

In Cyclone V GX/GT/SX/ST devices, there are two transmitter PLL sources: CMU PLL (channel PLL) and fPLL. The channel PLL can be used as CMU PLL to clock the transceivers or as clock data recovery (CDR) PLL.

Note: Cyclone V transceiver channels support full-duplex operation. The CMU PLL is sourced from the channel PLL of channels 1 or 4.

Table 1-8: Transmitter PLL Capability and Availability

Transmitter PLL	Serial Data Range	Availability
CMU PLL	0.611 Gbps to 6.144 Gbps	Every channel when not used as receiver CDR
fPLL	0.611 Gbps to 3.125 Gbps	Two per transceiver bank

Related Information

[Transceiver Clocking in Cyclone V Devices](#)

Channel PLL Architecture

In LTR mode, the channel PLL tracks the input reference clock. The PFD compares the phase and frequency of the voltage controlled oscillator (VCO) output and the input reference clock. The resulting PFD output controls the VCO output frequency to half the data rate with the appropriate counter (M or L) value given an input reference clock frequency. The lock detect determines whether the PLL has achieved lock to the phase and frequency of the input reference clock.

In LTD mode, the channel PLL tracks the incoming serial data. The phase detector compares the phase of the VCO output and the incoming serial data. The resulting phase detector output controls the VCO output to continuously match the phase of the incoming serial data.

The channel PLL supports operation in either LTR or LTD mode.

Note: Use the LTR/LTD controller only when the channel PLL is configured as a CDR PLL.

Table 1-9: Channel PLL Counters

The Quartus® II software automatically selects the appropriate counter values for each transceiver configuration.

Counter	Description	Values
N	Pre-scale counter to divide the input reference clock frequency to the PFD by the N factor	1, 2, 4, 8
M	Feedback loop counter to multiply the VCO frequency above the input reference frequency to the PFD by the M factor	1, 4, 5, 8, 10, 12, 16, 20, 25
L (PFD)	VCO post-scale counter to divide the VCO output frequency by the L factor in the LTR loop	1, 2, 4, 8

Counter	Description	Values
L (PD)	VCO post-scale counter to divide the VCO output frequency by the L factor in the LTD loop	1, 2, 4, 8

Channel PLL as CDR PLL

When configured as a receiver CDR, each channel PLL independently recovers the clock from the incoming serial data. The serial and parallel recovered clocks are used to clock the receiver PMA and PCS blocks.

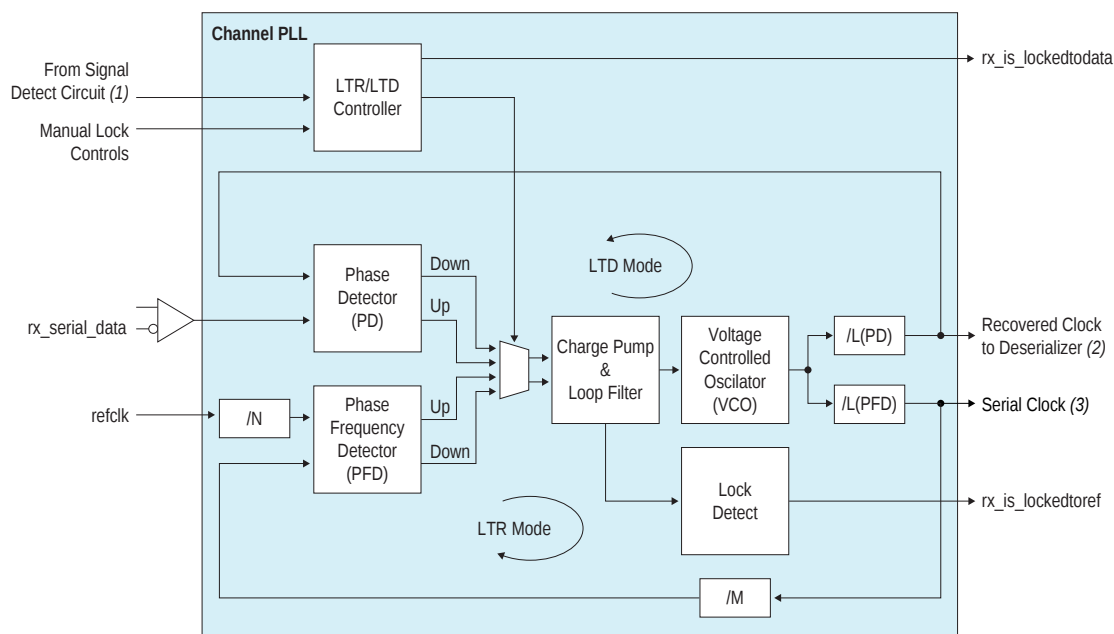
The CDR supports the full range of data rates. The voltage-controlled oscillator (VCO) operates at half rate. The L-counter dividers (PD) after the VCO extend the CDR data rate range. The Quartus II software automatically selects these settings.

The CDR operates in either lock-to-reference (LTR) or lock-to-data (LTD) mode. In LTR mode, the CDR tracks the input reference clock. In LTD mode, the CDR tracks the incoming serial data.

The time needed for the CDR PLL to lock to data depends on the transition density and jitter of the incoming serial data and the PPM difference between the receiver input reference clock and the upstream transmitter reference clock. You must hold the receiver PCS in reset until the CDR PLL locks to data and produces a stable recovered clock.

After the receiver power up and reset cycle, you must keep the CDR in LTR mode until the CDR locks to the input reference clock. When locked to the input reference clock, the CDR output clock is trained to the configured data rate. The CDR then switches to LTD mode to recover the clock from the incoming data. The LTR/LTD controller controls the switch between the LTR and LTD modes.

Figure 1-17: Channel PLL Block Diagram



Notes:

1. Applicable in a PCIe configuration and custom mode configuration, for example SATA/SAS.
2. Applicable when configured as a CDR PLL.
3. Applicable when configured as a CMU PLL.

Lock-to-Reference Mode

In LTR mode, the phase frequency detector (PFD) in the CDR tracks the receiver input reference clock. The PFD controls the charge pump that tunes the VCO in the CDR. Depending on the data rate and the selected input reference clock frequency, the Quartus II software automatically selects the appropriate /M and /L divider values so the CDR output clock frequency is half the data rate. The `rx_is_lockedtoref` status signal is asserted to indicate that the CDR has locked to the phase and frequency of the receiver input reference clock.

The phase detector is inactive in LTR mode and `rx_is_lockedtodata` is ignored.

Lock-to-Data Mode

During normal operation, the CDR must be in LTD mode to recover the clock from the incoming serial data. In LTD mode, the phase detector in the CDR tracks the incoming serial data at the receiver buffer. Depending on the phase difference between the incoming data and the CDR output clock, the phase detector controls the CDR charge pump that tunes the VCO.

Note: The PFD output is invalid in LTD mode. The `rx_is_lockedtoref` signal may toggle randomly and has no significance in LTD mode.

After switching to LTD mode, the `rx_is_lockedtodata` status signal is asserted. It can take a maximum of 1 ms for the CDR to lock to the incoming data and produce a stable recovered clock. The actual lock time depends on the transition density of the incoming data and the parts per million (ppm) difference between the receiver input reference clock and the upstream transmitter reference clock. The receiver PCS logic must be held in reset until the CDR produces a stable recovered clock.

CDR PLL in Automatic Lock Mode

In automatic lock mode, the LTR/LTD controller directs the transition between the LTR and LTD modes when a set of conditions are met to ensure proper CDR PLL operation. The mode transitions are indicated by the `rx_is_lockedtodata` status signal.

After power-up or reset of the receiver PMA, the CDR PLL is directed into LTR mode. The controller transitions the CDR PLL from LTR to LTD mode when all the following conditions are met:

- The frequency of the CDR PLL output clock and input reference clock is within the configured ppm frequency threshold setting
- The phase of the CDR PLL output clock and input reference clock is within approximately 0.08 unit interval (UI) of difference
- In PCIe configurations only—the signal detect circuitry must also detect the presence of the signal level at the receiver input above the threshold voltage specified in the PCI Express Base Specification 2.0. (Signal detect is an optional signal in Custom or Native PHY IP. Use the Assignment Editor to select the threshold voltage.)

The controller transitions the CDR PLL from LTD to LTR mode when either of the following conditions are met:

- The difference in between frequency of the CDR PLL output clock and input reference clock exceeds the configured ppm frequency threshold setting
- In PCIe configurations only—the signal detect circuitry detects the signal level at the receiver input below the threshold voltage specified in the PCI Express Base Specification 2.0

After switching to LTD mode, the `rx_is_lockedtoata` status signal is asserted. Lock to data takes a minimum of 4 μ s, however the actual lock time depends on the transition density of the incoming data and the parts per million (PPM) difference between the receiver input reference clock and the upstream transmitter reference clock. The receiver PCS logic must be held in reset until the CDR produces a stable recovered clock.

If there is no transition on the incoming serial data for an extended duration, the CDR output clock may drift to a frequency exceeding the configured PPM threshold when compared with the input reference clock. In such a case, the LTR/LTD controller transitions the CDR PLL from LTD to LTR mode.

CDR PLL in Manual Lock Mode

In manual lock mode, the LTR/LTD controller directs the transition between the LTR and LTD modes based on user-controlled settings in the `pma_rx_set_locktoata` and `pma_rx_set_locktoref` registers. Alternatively you can control it using the `rx_set_locktoata` and `rx_set_locktoref` ports available in the transceiver PHY IPs.

In LTR mode, the phase detector is not active. When the CDR PLL locks to the input reference clock, you can switch the CDR PLL to LTD mode to recover the clock and data from the incoming serial data.

In LTD mode, the PFD output is not valid and may cause the lock detect status indicator to toggle randomly. When there is no transition on the incoming serial data for an extended duration, you must switch the CDR PLL to LTR mode to wait for the read serial data.

Manual lock mode provides the flexibility to manually control the CDR PLL mode transitions bypassing the PPM detection as required by certain applications that include, but not limited to, the following:

- Link with frequency differences between the upstream transmitter and the local receiver clocks exceeding the CDR PLL ppm threshold detection capability. For example, a system with asynchronous spread-spectrum clocking (SSC) downspread of -0.5% where the SSC modulation results in a PPM difference of up to 5000.
- Link that requires a faster CDR PLL transition to LTD mode, avoiding the duration incurred by the PPM detection in automatic lock mode.

In manual lock mode, your design must include a mechanism—similar to a PPM detector—that ensures the CDR PLL output clock is kept close to the optimum recovered clock rate before recovering the clock and data. Otherwise, the CDR PLL might not achieve locking to data. If the CDR PLL output clock frequency is detected as not close to the optimum recovered clock rate in LTD mode, direct the CDR PLL to LTR mode.

Related Information

[*Transceiver Reset Control and Power Down in Cyclone V Devices*](#)

Channel PLL as a CMU PLL

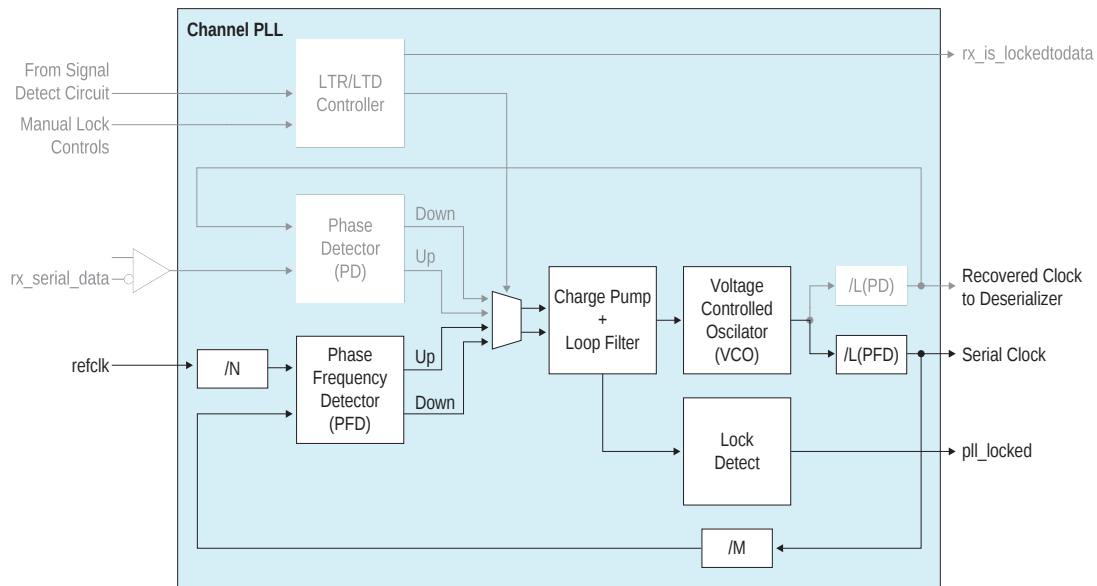
When you use the channel PLL as the CMU PLL, you can configure the transceiver channel only as a transmitter.

The CMU PLL operates in LTR mode only and supports the full range of data rates.

The VCO of the PLL operates at half rate and the L-counter dividers (PFD), after the VCO, extend the PLL data rate range.

Note: CDR functionality for the receiver is not available when you configure the channel PLL as a CMU PLL—you can use the transceiver channel only as a transmitter.

Figure 1-18: CMU PLL in Cyclone V Devices



The CMU PLL output serial clock, with a frequency that is half of the data rate, feeds the clock divider that resides in the transmitter of the same transceiver channel. The CMU PLLs in channels 1 and 4 feed the x1 and x6 clock lines.

Related Information

[Transceiver Clocking in Cyclone V Devices](#)

fPLL as a Transmitter PLL

In addition to CMU PLL, the fPLL located adjacent to the transceiver banks are available for clocking the transmitters for serial data rates up to 3.125 Gbps.

Related Information

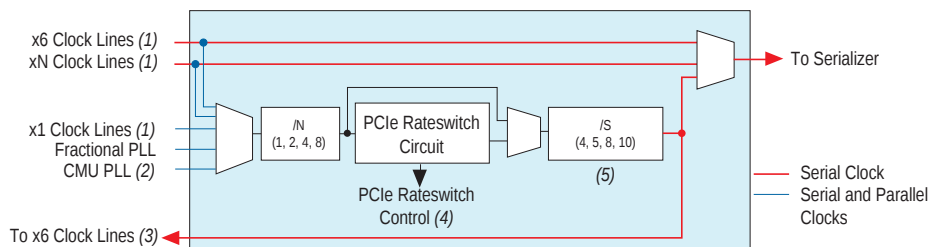
[Clock Networks and PLLs in Cyclone V Devices](#)

Clock Divider

Each Cyclone V transmitter channel has a clock divider.

There are two types of clock dividers, depending on the channel location in a transceiver bank:

- Local clock divider—channels 0, 2, 3, and 5 provide serial and parallel clocks to the PMA
- Central clock divider—channels 1 and 4 can drive the x6 and xN clock lines

Figure 1-19: Clock Divider for a Transceiver Channel in Cyclone V Devices**Notes:**

1. For information about the x1, x6, and xN clock lines, refer to *Transceiver Clocking in Cyclone V Devices*.
2. Only from the channel PLL in the same transceiver channel configured as a CMU PLL.
3. Applicable for central clock dividers only (clock dividers in channels 1 and 4).
4. The PCIe rateswitch circuit allows dynamic switching between Gen2 and Gen1 line rates in a PCIe Gen2 design.
5. The divider settings are configured automatically depending on the serialization factor. The selected divider setting is half of the serialization factor.

Both types of clock dividers can divide the serial clock input to provide the parallel and serial clocks for the serializer in the channel if you use clocks from the clock lines or transmit PLLs. The central clock divider can additionally drive the x6 clock lines used to bond multiple channels.

In bonded channel configurations, both types of clock dividers can feed the serializer with the parallel and serial clocks directly, without dividing them from the x6 or xN clock lines.

Related Information

[Transceiver Clocking in Cyclone V Devices](#)

Calibration Block

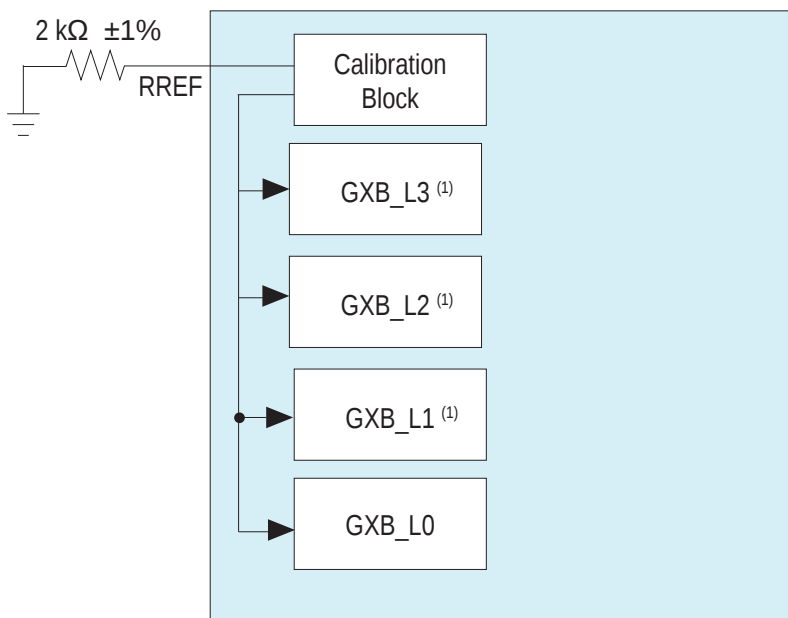
The calibration block calibrates the differential OCT resistance and analog circuitry in the transceiver PMA to ensure the functionality is independent of PVT.

It is also used for duty cycle calibration of the clock line at serial data rates ≥ 4.9152 Gbps.

There is only one calibration block available for the Cyclone V transceiver PMA. It is located on the top left of the device (same side as the transceiver channels).

Figure 1-20: Calibration Block Location and Connections in Cyclone V Devices

Transceivers are on the left side of the device only.



Note:

1. GXB_L1, GXB_L2, and GXB_L3 banks are only available in some device variants.

The calibration block internally generates a constant internal reference voltage, independent of PVT variations. The block uses the internal reference voltage and external reference resistor to generate constant reference currents.

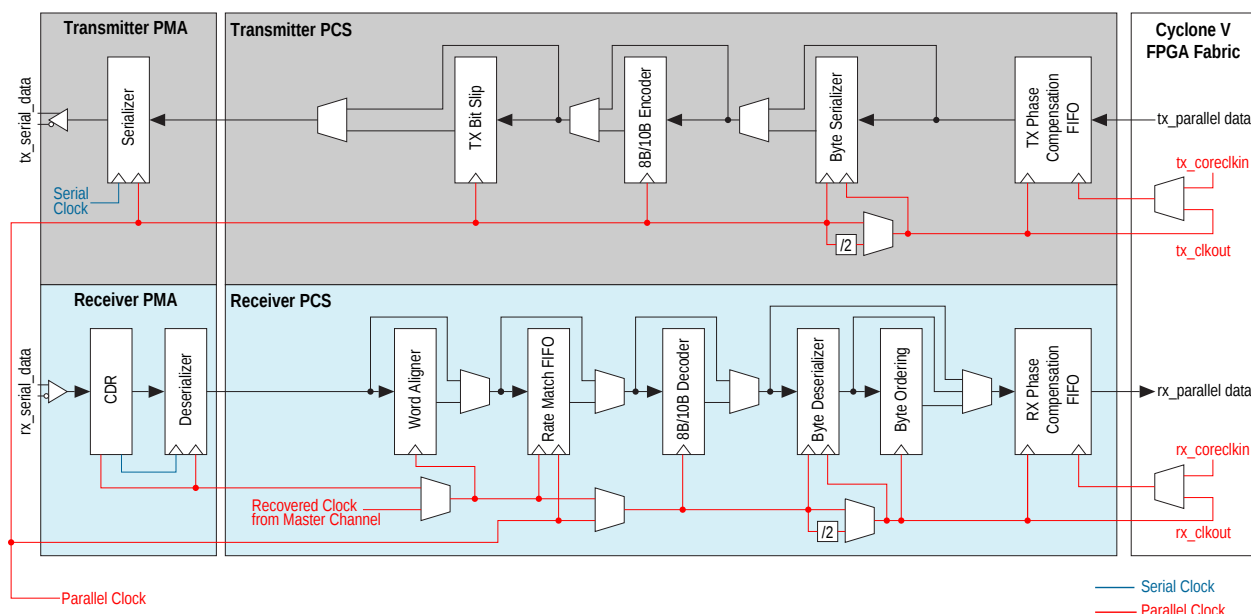
Note: You must connect the external reference resistor to the RREF pin.

These reference currents are used by the analog block calibration circuit to calibrate the transceiver banks. You must connect a separate $2\text{ k}\Omega$ (tolerance max $\pm 1\%$) external resistor on each RREF pin to ground. To ensure the calibration block operates properly, the RREF resistor connection in the board must be free from external noise.

PCS Architecture

Figure 1-21: PCS Block Diagram of a Transceiver Channel in a Cyclone V Device

The serial and parallel clocks are sourced from the clock divider.



The transceiver channel PCS datapath is categorized into two configurations—single-width and double-width, based on the transceiver channel PMA-PCS width (or serialization/deserialization factor).

Table 1-10: PCS Datapath Configurations

Parameters	Single-Width	Double-Width
PMA-PCS Interface Width	8 or 10 bit	16 or 20 bit
FPGA Fabric-Transceiver Interface Width	8 or 10 bit 16 or 20 bit ⁽²⁾	16 or 20 bit 32 or 40 bit ⁽²⁾

⁽²⁾ The byte serializer and deserializer are enabled.

Transmitter PCS Datapath

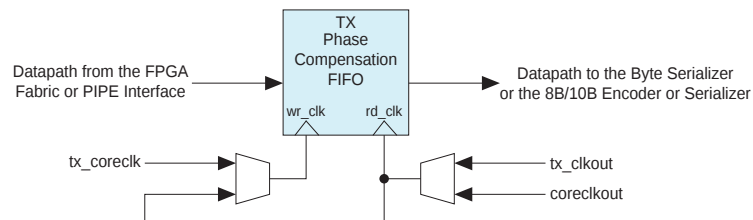
Table 1-11: Blocks in the Transmitter PCS Datapath

Block	Functionality
Transmitter Phase Compensation FIFO	<ul style="list-style-type: none"> Compensates for the phase difference between the low-speed parallel clock and the FPGA fabric interface clock, when interfacing the transmitter PCS with the FPGA fabric directly or with the PCIe hard IP block Supports operation in phase compensation and registered modes
Byte Serializer	<ul style="list-style-type: none"> Halves the FPGA fabric–transceiver interface frequency at the transmitter channel by doubling the transmitter input datapath width Allows the transmitter channel to operate at higher data rates with the FPGA fabric–transceiver interface frequency that is within the maximum limit Supports operation in single- and double-width modes
8B/10B Encoder	<ul style="list-style-type: none"> Generates 10-bit code groups from 8-bit data and the 1-bit control identifier in compliance with Clause 36 of the IEEE 802.3 specification Supports operation in single- and double-width modes and running disparity control
Transmitter Bit-Slip	<ul style="list-style-type: none"> Enables user-controlled, bit-level delay in the data prior to serialization for serial transmission Supports operation in single- and double-width modes

Transmitter Phase Compensation FIFO

The transmitter phase compensation FIFO is four words deep and interfaces with the transmitter channel PCS and the FPGA fabric or PCIe hard IP block. The transmitter phase compensation FIFO compensates for the phase difference between the low-speed parallel clock and the FPGA fabric interface clock.

Figure 1-22: Transmitter Phase Compensation FIFO



The transmitter phase compensation FIFO supports two operations:

- Phase compensation mode with various clocking modes on the read clock and write clock
- Registered mode with only one clock cycle of datapath latency

Registered Mode

To eliminate the FIFO latency uncertainty for applications with stringent datapath latency uncertainty requirements, bypass the FIFO functionality in registered mode to incur only one clock cycle of datapath latency when interfacing the transmitter channel to the FPGA fabric. Configure the FIFO to registered mode when interfacing the transmitter channel to the FPGA fabric or PCIe hard IP block to reduce datapath latency. In registered mode, the low-speed parallel clock that is used in the transmitter PCS clocks the FIFO.

Phase Compensation Mode

The transmitter phase compensation FIFO compensates for any phase difference between the read and write clocks for the transmitter control and data signals. The low-speed parallel clock feeds the read clock, while the FPGA fabric interface clock feeds the write clock. The clocks must have 0 ppm difference in frequency or a FIFO underrun or overflow condition may result.

The FIFO supports various clocking modes on the read and write clocks depending on the transceiver configuration.

Related Information

[Transceiver Clocking in Cyclone V Devices](#)

Byte Serializer

The byte serializer divides the input datapath by two to run the transceiver channel at higher data rates while keeping the FPGA fabric interface frequency within the maximum limit.

The byte serializer supports operation in single- and double-width modes. The datapath clock rate at the output of the byte serializer is twice the FPGA fabric–transmitter interface clock frequency. The byte serializer forwards the least significant word first followed by the most significant word.

Note: You must use the byte serializer in configurations that exceed the maximum frequency limit of the FPGA fabric–transceiver interface.

Byte Serializer in Single-Width Mode

The byte serializer forwards the LSByte first, followed by the MSByte. The input data width to the byte serializer depends on the channel width option. For example, in single-width mode with a channel width of 20 bits, the byte serializer sends out the least significant word `tx_parallel_data[9:0]` of the parallel data from the FPGA fabric, followed by `tx_parallel_data[19:10]`.

Table 1-12: Input and Output Data Width of the Byte Serializer in Single-Width Mode for Cyclone V Devices

Mode	Input Data Width to the Byte Serializer	Output Data Width from the Byte Serializer	Byte Serializer Output Ordering
Single-width	16	8	Least significant 8 bits of the 16-bit output first
	20	10	Least significant 10 bits of the 20-bit output first

Byte Serializer in Double-Width Mode

The operation in double-width mode is similar to that of single-width mode. For example, in double-width mode with a channel width of 32 bits, the byte serializer forwards `tx_parallel_data[15:0]` first, followed by `tx_parallel_data[31:16]`.

Table 1-13: Input and Output Data Width of the Byte Serializer in Double-Width Mode for Cyclone V Devices

Mode	Input Data Width to the Byte Serializer	Output Data Width from the Byte Serializer	Byte Serializer Output Ordering
Double-width	32	16	Least significant 16 bits of the 32-bit output first
	40	20	Least significant 20 bits of the 40-bit output first

If you select the **8B/10B Encoder** option, the 8B/10B encoder uses the output from the byte serializer. Otherwise, the byte serializer output is forwarded to the serializer.

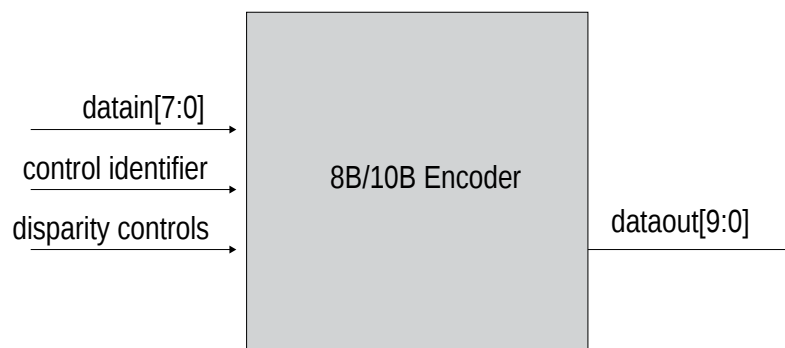
8B/10B Encoder

The 8B/10B encoder supports operation in single- and double-width modes with the running disparity control feature.

8B/10B Encoder in Single-Width Mode

In single-width mode, the 8B/10B encoder generates 10-bit code groups from 8-bit data and 1-bit control identifier with proper disparity according to the PCS reference diagram in the Clause 36 of the IEEE 802.3 specification. The 10-bit code groups are generated as valid data code-groups (/Dx.y/) or special control code-groups (/Kx.y/), depending on the 1-bit control identifier.

Figure 1-23: 8B/10B Encoder in Single-Width Mode



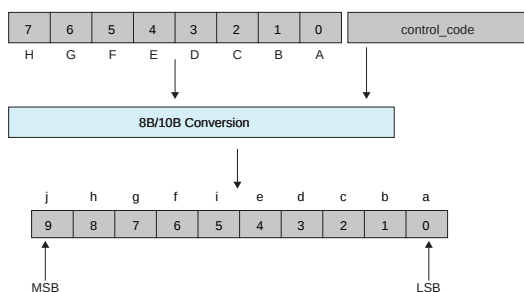
The IEEE 802.3 specification identifies only 12 sets of 8-bit characters as /Kx.y/. If other sets of 8-bit characters are set to encode as special control code-groups, the 8B/10B encoder may encode the output 10-bit code as an invalid code (it does not map to a valid /Dx.y/ or /Kx.y/ code), or unintended valid /Dx.y/ code, depending on the value entered.

In single-width mode, the 8B/10B encoder translates the 8-bit data to a 10-bit code group (control word or data word) with proper disparity. If the `tx_dataak` input is high, the 8B/10B encoder translates the input

`data[7:0]` to a 10-bit control word. If the `tx_dataak` input is low, the 8B/10B encoder translates the input `data[7:0]` to a 10-bit data word.

Figure 1-24: 8B/10B Conversion Format

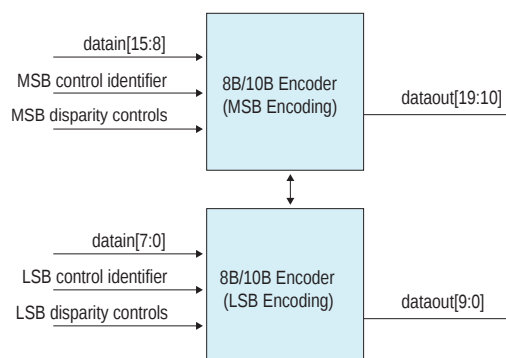
The LSB is transmitted first.



8B/10B Encoder in Double-Width Mode

In double-width mode, two 8B/10B encoders are cascaded to generate two sets of 10-bit code groups from 16-bit data and two 1-bit control identifiers. When receiving the 16-bit data, the 8-bit LSByte is encoded first, followed by the 8-bit MSByte.

Figure 1-25: 8B/10B Encoder in Double-Width Mode



Running Disparity Control

The 8B/10B encoder automatically performs calculations that meet the running disparity rules when generating the 10-bit code groups. The running disparity control feature provides user-controlled signals (`tx_dispv` and `tx_forcedisp`) to manually force encoding into a positive or negative current running disparity code group. When you enable running disparity control, the control overwrites the current running disparity value in the encoder based on the user-controlled signals, regardless of the internally-computed current running disparity in that cycle.

Note: Using running disparity control may temporarily cause a running disparity error at the receiver.

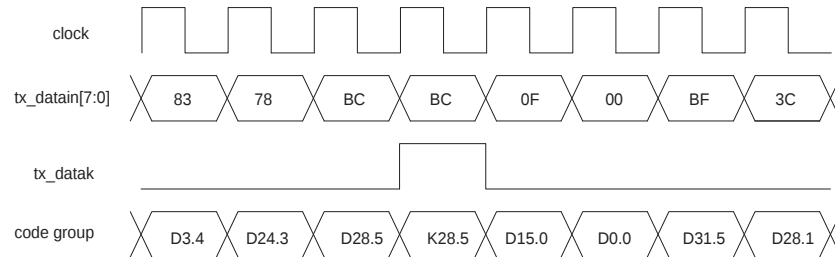
Control Code Encoding

The 8B/10B block provides the `tx_dataak` signal to indicate whether the 8-bit data at the `tx_parallel_data` signal should be encoded as a control word (Kx.y) or a data word (Dx.y). When

`tx_dataak` is low, the 8B/10B encoder block encodes the byte at the `tx_parallel_data` signal as data ($Dx.y$). When `tx_dataak` is high, the 8B/10B encoder encodes the input data as a $Kx.y$ code group. The rest of the `tx_parallel_data` bytes are encoded as a data word ($Dx.y$).

Figure 1-26: Control Word and Data Word Transmission

The second 0xBC is encoded as a control word (K28.5).



Note: The IEEE802.3 8B/10B encoder specification identifies only a set of 8-bit characters for which you must assert `tx_dataak`. If you assert `tx_dataak` for any other set of bytes, the 8B/10B encoder might encode the output 10-bit code as an invalid code (it does not map to a valid $Dx.y$ or $Kx.y$ code), or unintended valid $Dx.y$ code, depending on the value entered. It is possible for a downstream 8B/10B decoder to decode an invalid control word into a valid $Dx.y$ code without asserting code error flags.

Reset Condition

The `reset_tx_digital` signal resets the 8B/10B encoder. During reset, the running disparity and data registers are cleared. Also, the 8B/10B encoder outputs a K28.5 pattern from the RD- column continuously until `reset_tx_digital` is deasserted. The input data and control code from the FPGA fabric is ignored during the reset state. After reset, the 8B/10B encoder starts with a negative disparity (RD-) and transmits three K28.5 code groups for synchronization before it starts encoding and transmitting the data on its output.

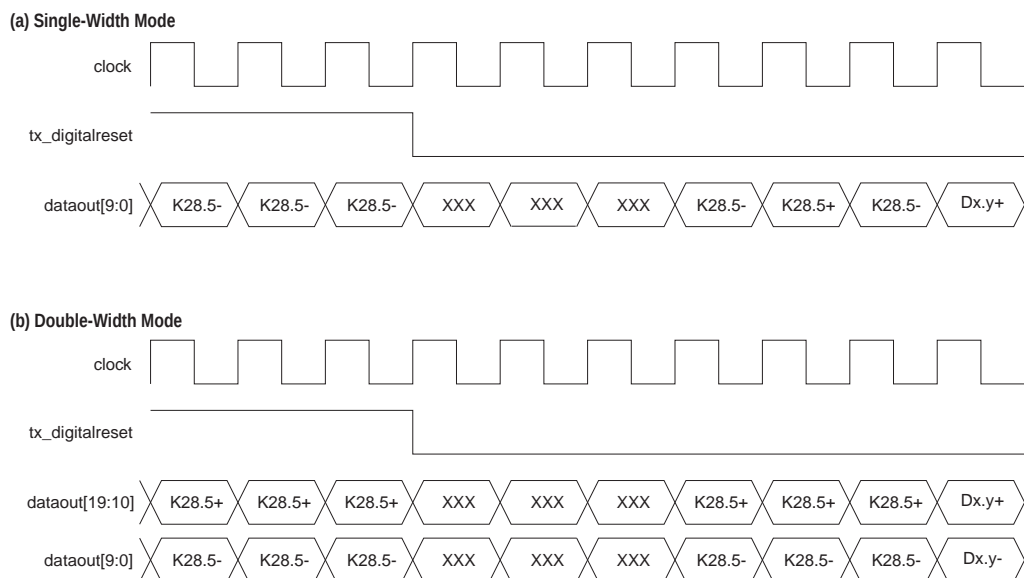
Note: While `reset_tx_digital` is asserted, the downstream 8B/10B decoder that receives the data might observe synchronization or disparity errors.

Encoder Output During Reset Sequence

When in reset (`reset_tx_digital` is high), a K28.5- (K28.5 10-bit code group from the RD- column) is sent continuously until `reset_tx_digital` is low. Because of some pipelining of the transmitter channel PCS, some “don’t cares” (10’hxxx) are sent before the three synchronizing K28.5 code groups. User data follows the third K28.5 code group.

Figure 1-27: 8B/10B Encoder Output During and After Reset Conditions

8B/10B encoder output during and after reset conditions in both single- and double-width modes.

**Table 1-14: 8B/10B Encoder Output During and After Reset Conditions**

Operation Mode	During 8B/10B Reset	After 8B/10B Reset Release
Single Width	Continuously sends the /K28.5/ code from the RD- column	Some “don't cares” are seen due to pipelining in the transmitter channel, followed by three /K28.5/ codes with proper disparity—starts with negative disparity—before sending encoded 8-bit data at its input.
Double Width	Continuously sends the /K28.5/ code from the RD- column on the LSByte and the /K28.5/ code from the RD+ column on the MSByte	Some “don't cares” are seen due to pipelining in the transmitter channel, followed by: <ul style="list-style-type: none"> Three /K28.5/ codes from the RD- column before sending encoded 8-bit data at its input on LSByte. Three /K28.5/ codes from the RD+ column before sending encoded 8-bit data at its input on MSByte.

Transmitter Bit-Slip

The transmitter bit-slip allows you to compensate for the channel-to-channel skew between multiple transmitter channels by slipping the data sent to the PMA. The maximum number of bits slipped is controlled from the FPGA fabric and is equal to the width of the PMA-PCS minus 1.

Table 1-15: Bits Slip Allowed with the `tx_bitslipboundaryselect` signal

Operation Mode	Maximum Bit-Slip Setting
Single width (8 or 10 bit)	9
Double width (16 or 20 bit)	19

Receiver PCS Datapath

The sub-blocks in the receiver PCS datapath are described in order from the word aligner to the receiver phase compensation FIFO block.

Table 1-16: Blocks in the Receiver PCS Datapath

Block	Functionality
Word Aligner	<ul style="list-style-type: none"> Searches for a predefined alignment pattern in the deserialized data to identify the correct boundary and restores the word boundary during link synchronization Supports an alignment pattern length of 7, 8, 10, 16, 20, or 32 bits Supports operation in four modes—manual alignment, bit-slip, automatic synchronization state machine, and deterministic latency state machine—in single- and double-width configurations Supports the optional programmable run-length violation detection, polarity inversion, bit reversal, and byte reversal features
Rate Match FIFO	<ul style="list-style-type: none"> Compensates for small clock frequency differences of up to ± 300 parts per million (ppm)—600 ppm total—between the upstream transmitter and the local receiver clocks by inserting or deleting skip symbols when necessary Supports operation that is compliant to the clock rate compensation function in supported protocols
8B/10B Decoder	<ul style="list-style-type: none"> Receives 10-bit data and decodes the data into an 8-bit data and a 1-bit control identifier—in compliance with Clause 36 of the IEEE 802.3 specification Supports operation in single- and double-width modes
Byte Deserializer	<ul style="list-style-type: none"> Halves the FPGA fabric–transceiver interface frequency at the receiver channel by doubling the receiver output datapath width Allows the receiver channel to operate at higher data rates with the FPGA fabric–transceiver interface frequency that is within maximum limit Supports operation in single- and double-width modes
Byte Ordering	<ul style="list-style-type: none"> Searches for a predefined pattern that must be ordered to the LSByte position in the parallel data going to the FPGA fabric when you enable the byte deserializer

Block	Functionality
Receiver Phase Compensation FIFO	<ul style="list-style-type: none">Compensates for the phase difference between the low-speed parallel clock and the FPGA fabric interface clock when interfacing the receiver PCS with the FPGA fabric directly or with the PCIe hard IP blockSupports operation in phase compensation and registered modes

Word Aligner

Parallel data at the input of the receiver PCS loses the word boundary of the upstream transmitter from the serial-to-parallel conversion in the deserializer. The word aligner receives parallel data from the deserializer and restores the word boundary based on a pre-defined alignment pattern that must be received during link synchronization.

The word aligner searches for a pre-defined alignment pattern in the deserialized data to identify the correct boundary and restores the word boundary during link synchronization. The alignment pattern is pre-defined for standard serial protocols according to the respective protocol specifications for achieving synchronization. For proprietary protocol implementations, you can specify a custom word alignment pattern specific to your application.

In addition to restoring the word boundary, the word aligner implements the following features:

- Synchronization state machine
- Programmable run length violation detection (for all transceiver configurations)
- Receiver polarity inversion (for all transceiver configurations except PCIe)
- Receiver bit reversal (for custom single- and double-width configurations only)
- Receiver byte reversal (for custom double-width configuration only)

The word aligner operates in one of the following three modes:

- Manual alignment
- Automatic synchronization state machine
- Bit-slip
- Deterministic latency state machine

Except for bit-slip mode, after completing word alignment, the deserialized data is synchronized to have the word alignment pattern at the LSB portion of the aligned data.

Word Aligner Options and Behaviors

The operation mode and alignment pattern length support varies depending on the word aligner configurations.

Table 1-17: Word Aligner Options and Behaviors

PMA-PCS Interface Width (bits)	Word Alignment Mode	Word Alignment Pattern Length (bits)	Word Alignment Behavior
8	Manual Alignment	16	User-controlled signal starts the alignment process. Alignment happens once unless the signal is reasserted.
	Bit-Slip	16	User-controlled signal shifts data one bit at a time.

PMA-PCS Interface Width (bits)	Word Alignment Mode	Word Alignment Pattern Length (bits)	Word Alignment Behavior
10	Manual Alignment	7 and 10	User-controlled signal starts the alignment process. Alignment happens once unless the signal is reasserted.
	Bit-Slip	7 and 10	User-controlled signal shifts data one bit at a time.
	Automatic Synchronized State Machine	7 and 10	Data is required to be 8B/10B encoded. Aligns to selected word aligner pattern when pre-defined conditions are satisfied.
	Deterministic Latency State Machine	10	User-controlled signal starts the alignment process. After the pattern is found and the word boundary is identified, the state machine controls the deserializer to clock-slip the boundary-indicated number of serial bits.
16	Manual Alignment	8, 16, and 32	Alignment happens automatically after RX PCS reset. User-controlled signal starts the alignment process thereafter. Alignment happens once unless the signal is reasserted.
	Bit-Slip	8, 16, and 32	User-controlled signal shifts data one bit at a time.
20	Manual Alignment	7, 10, and 20	Alignment happens automatically after RX PCS reset. User-controlled signal starts the alignment process thereafter. Alignment happens once unless the signal is reasserted.
	Bit-Slip	7, 10, and 20	User-controlled signal shifts data one bit at a time.
	Deterministic Latency State Machine	10 and 20	User-controlled signal starts the alignment process. After the pattern is found and the word boundary is identified, the state machine controls the deserializer to clock-slip the boundary-indicated number of serial bits.

Word Aligner in Manual Alignment Mode

In manual alignment mode, word alignment is manually controlled with the `rx_enapatternalign` register. Depending on the configuration, controlling the `rx_enapatternalign` register enables the word aligner to look for the predefined word alignment pattern in the received data stream and automatically synchronizes to the new word boundary.

Table 1-18: Word Aligner Operations in Manual Alignment Mode

PCS Mode	PMA-PCS Interface Width (bits)	Word Alignment Operation
Single Width	8	<ol style="list-style-type: none"> 1. After the <code>rx_digitalreset</code> signal deasserts, a 0-to-1 transition on the <code>rx_enapatternalign</code> register triggers the word aligner to look for the predefined word alignment pattern in the received data stream and automatically synchronize to the new word boundary. 2. Any alignment pattern found thereafter in a different word boundary does not cause the word aligner to resynchronize to this new word boundary because there is a lack of a preceding 0-to-1 transition on the <code>rx_enapatternalign</code> register. 3. To resynchronize to the new word boundary, create a 0-to-1 transition in the <code>rx_enapatternalign</code> register. 4. If you set the <code>rx_enapatternalign</code> register to 1 before the deassertion of the <code>rx_digitalreset</code> signal, the word aligner updates the word boundary when the first alignment pattern is found, even though a 0-to-1 transition was not explicitly generated. 5. To resynchronize to the new word boundary, create a 0-to-1 transition to the <code>rx_enapatternalign</code> register. 6. When the word aligner synchronized to the new word boundary, the <code>rx_patterndetect</code> and <code>rx_syncstatus</code> signals will assert for one parallel clock cycle.
	10	<ol style="list-style-type: none"> 1. After the <code>rx_digitalreset</code> signal deasserts, setting the <code>rx_enapatternalign</code> register to 1 triggers the word aligner to look for the predefined word alignment pattern, or its complement in the received data stream, and automatically synchronize to the new word boundary. 2. Any alignment pattern found thereafter in a different word boundary causes the word aligner to resynchronize to this new word boundary if the <code>rx_enapatternalign</code> register remains set to 1. 3. If you set the <code>rx_enapatternalign</code> register to 0, the word aligner maintains the current word boundary even when it finds the alignment pattern in a new word boundary. 4. When the word aligner synchronized to the new word boundary, the <code>rx_patterndetect</code> and <code>rx_syncstatus</code> signals will assert for one parallel clock cycle.

PCS Mode	PMA-PCS Interface Width (bits)	Word Alignment Operation
Double Width	16	<ol style="list-style-type: none"> 1. After the <code>rx_digitalreset</code> signal deasserts, regardless of the setting in the <code>rx_enapatternalign</code> register, the word aligner synchronizes to the first predefined alignment pattern found. 2. Any alignment pattern found thereafter in a different word boundary does not cause the word aligner to resynchronize to this new word boundary. 3. To resynchronize to the new word boundary, create a 0-to-1 transition in the <code>rx_enapatternalign</code> register. 4. When the word aligner synchronized to the new word boundary, the <code>rx_patterndetect</code> and <code>rx_syncstatus</code> signals will assert for one parallel clock cycle. The <code>rx_syncstatus</code> signal will deassert if the next rising edge of <code>rx_enapatternalign</code> is detected.
	20	

Word Aligner in Bit-Slip Mode

In bit-slip mode, the word aligner is controlled by the `rx_bitslip` bit of the `pcs8g_rx_wa_control` register. At every 0-1 transition of the `rx_bitslip` bit of the `pcs8g_rx_wa_control` register, the bit-slip circuitry slips one bit into the received data stream, effectively shifting the word boundary by one bit. Also in bit-slip mode, the word aligner `pcs8g_rx_wa_status` register bit for `rx_patterndetect` is driven high for one parallel clock cycle when the received data after bit-slipping matches the 16-bit word alignment pattern programmed.

To achieve word alignment, you can implement a bit-slip controller in the FPGA fabric that monitors the `rx_parallel_data` signal, the `rx_patterndetect` signal, or both, and controls them with the `rx_bitslip` signal.

Table 1-19: Word Aligner in Bit-Slip Mode

PCS Mode	PMA-PCS Interface Width (bits)	Word Alignment Operation
Single Width	8	<ol style="list-style-type: none"> 1. At every rising edge to the <code>rx_bitslip</code> signal, the word aligner slips one bit into the received data.
	10	
Double Width	16	<ol style="list-style-type: none"> 2. When bit-slipping shifts a complete round of the data bus width, the word boundary is back to the original boundary. 3. Use the <code>rx_patterndetect</code> signal assertion or check the data output to indicate completion of alignment process—where the word aligner output matches the predefined alignment pattern.
	20	

Note: For every bit slipped in the word aligner, the earliest bit received is lost.

Word Aligner in Automatic Synchronization State Machine Mode

In automatic synchronization state machine mode, a programmable state machine determines the moment that the word aligner has either achieved synchronization or lost synchronization.

You can configure the state machine to provide hysteresis control during link synchronization and throughout normal link operation. Depending on your protocol configurations, the state machine parameters are automatically configured so they are compliant with the synchronization state machine in the respective protocol specification.

Table 1-20: Programmable Parameters for the Word Aligner in Synchronization State Machine Mode

Parameter	Values
Number of valid synchronization code groups or ordered sets received to achieve synchronization	1–256
Number of erroneous code groups received to lose synchronization	1–64
Number of continuous good code groups received to reduce the error count by one	1–256

Table 1-21: Word Aligner Operation in Automatic Synchronization State Machine Mode

PCS Mode	PMA–PCS Interface Width	Word Alignment Operation
Single Width	10 bits	<ol style="list-style-type: none">1. After the <code>rx_digitalreset</code> signal deasserts, the word aligner starts looking for the predefined word alignment pattern, or its complement, in the received data stream and automatically aligns to the new word boundary.2. Synchronization is achieved only after the word aligner receives the programmed number of valid synchronization code groups in the same word boundary and is indicated with the assertion of the <code>rx_syncstatus</code> signal.3. After assertion and achieving synchronization, the <code>rx_syncstatus</code> signal remains asserted until the word aligner loses synchronization.4. Loss of synchronization occurs when the word aligner receives the programmed number of erroneous code groups without receiving the intermediate good code groups and is indicated with the deassertion of the <code>rx_syncstatus</code> signal.5. The word aligner may achieve synchronization again after receiving a new programmed number of valid synchronization code groups in the same word boundary.

Word Aligner in Automatic Synchronization State Machine Mode with a 10-Bit PMA-PCS Interface Configuration

Protocols such as PCIe require the receiver PCS logic to implement a synchronization state machine to provide hysteresis during link synchronization. Each of these protocols defines a specific number of

synchronization code groups that the link must receive to acquire synchronization and a specific number of erroneous code groups that it must receive to fall out of synchronization.

In PCIe configurations, the word aligner in automatic synchronization state machine mode automatically selects the word alignment pattern length and pattern as specified by each protocol. The synchronization state machine parameters are fixed for PCIe configurations as specified by the respective protocol.

Table 1-22: Word Aligner in Synchronization State Machine Modes for a PCIe Configuration

Mode	PCIe
Number of valid synchronization code groups or ordered sets received to achieve synchronization	4
Number of erroneous code groups received to lose synchronization	17
Number of continuous good code groups received to reduce the error count by one	16

After deassertion of the `reset_rx_digital` signal in automatic synchronization state machine mode, the word aligner starts looking for the word alignment pattern or synchronization code groups in the received data stream. When the programmed number of valid synchronization code groups or ordered sets is received, the `rx_syncstatus` status bit is driven high to indicate that synchronization is acquired. The `rx_syncstatus` status bit is constantly driven high until the programmed number of erroneous code groups is received without receiving intermediate good groups; after which `rx_syncstatus` is driven low. The word aligner indicates loss of synchronization (`rx_syncstatus` remains low) until the programmed number of valid synchronization code groups are received again.

Word Aligner Operations in Deterministic Latency State Machine Mode

In deterministic latency state machine mode, word alignment is achieved by performing a clock-slip in the deserializer until the deserialized data coming into the receiver PCS is word-aligned. The deterministic latency state machine controls the clock-slip process in the deserializer after the word aligner has found the alignment pattern and has identified the word boundary. Deterministic latency state machine mode offers a reduced latency uncertainty in the word alignment operation for applications that require deterministic latency.

Table 1-23: Word Aligner Operations in Deterministic Latency State Machine Mode

PCS Mode	PMA-PCS Interface Width	Word Alignment Operation
Single Width	10 bits	<ol style="list-style-type: none"> 1. After the <code>rx_digitalreset</code> signal deasserts, a 0-to-1 transition in the <code>rx_enapatternalign</code> register triggers the word aligner to look for the predefined word alignment pattern, or its complement, in the received data stream. 2. After the pattern is found and the word boundary is identified, the state machine controls the deserializer to clock-slip the boundary-indicated number of serial bits. 3. When clock-slip is complete, the deserialized data coming into the receiver PCS is word-aligned and indicated when the <code>rx_syncstatus</code> signal asserts.
Double Width	20 bits	

Programmable Run-Length Violation Detection

The programmable run-length violation detection circuit resides in the word aligner block and detects if consecutive 1s or 0s in the received data exceed the user-specified threshold.

If the data stream exceeds the preset maximum number of consecutive 1s or 0s, the violation is signified by the assertion of the `rx_rlv` status bit.

Table 1-24: Detection Capabilities of the Run-Length Violation Circuit

PCS Mode	PMA-PCS Interface Width (bits)	Run-Length Violation Detector Range	
		Minimum	Maximum
Single Width	8	4	128
	10	5	160
Double Width	16	8	512
	20	10	640

Receiver Polarity Inversion

The positive and negative signals of a serial differential link might erroneously be swapped during board layout. Solutions such as board re-spin or major updates to the PLD logic can be expensive. The polarity inversion feature at the receiver corrects the swapped signal error without requiring board re-spin or major updates to the logic in the FPGA fabric. The polarity inversion feature inverts the polarity of every bit at the input to the word aligner, which has the same effect as swapping the positive and negative signals of the serial differential link.

Inversion is controlled dynamically with the `rx_invpolarity` register. When you enable the polarity inversion feature, initial disparity errors may occur at the receiver with the 8B/10B-coded data. The receiver must be able to tolerate these disparity errors.

Caution: If you enable polarity inversion midway through a word, the word will be corrupted.

Bit Reversal

By default, the receiver assumes a LSB-to-MSB transmission. If the transmission order is MSB-to-LSB, the receiver forwards the bit-flipped version of the parallel data to the FPGA fabric on `rx_parallel_data`. To reverse the bit order at the output of the word aligner to receive a MSB-to-LSB transmission, use the bit reversal feature at the receiver.

Table 1-25: Bit Reversal Feature

Bit Reversal Option	Received Bit Order	
	Single-Width Mode (8 or 10 bit)	Double-Width Mode (16 or 20 bit)
Disabled (default)	LSB to MSB	LSB to MSB

Bit Reversal Option	Received Bit Order	
	Single-Width Mode (8 or 10 bit)	Double-Width Mode (16 or 20 bit)
Enabled	MSB to LSB For example: 8-bit-D[7:0] rewired to D[0:7] 10-bit-D[9:0] rewired to D[0:9]	MSB to LSB For example: 16-bit-D[15:0] rewired to D[0:15] 20-bit-D[19:0] rewired to D[0:19]

Note: When receiving the MSB-to-LSB transmission, the word aligner receives the data in reverse order. The word alignment pattern must be reversed accordingly to match the MSB first incoming data ordering.

You can dynamically control the bit reversal feature to use the `rx_bitreversal_enable` register with the word aligner in bit-slip mode. When you dynamically enable the bit reversal feature in bit-slip mode, ignore the pattern detection function in the word aligner because the word alignment pattern cannot be dynamically reversed to match the MSB first incoming data order.

Receiver Byte Reversal

In double-width mode, two symbols of incoming data at the receiver may be accidentally swapped during transmission. For a 16-bit input data width at the word aligner, the two symbols are bits[15:8] and bits[7:0]. For a 20-bit input data width at the word aligner, the two symbols are bits[19:10] and bits[9:0]. The byte reversal feature at the word aligner output corrects the swapped signal error by swapping the two symbols in double-width mode at the word aligner output, as listed in [Table 1-26](#).

Table 1-26: Byte Reversal Feature

Byte Reversal Option	Word Aligner Output	
	16-bit Data Width	20-bit Data Width
Disabled	D[15:0]	D[19:0]
Enabled	D[7:0], D[15:8]	D[9:0], D[19:10]

The reversal is controlled dynamically using the `rx_bytereversal_enable` register, and when you enable the receiver byte reversal option, this may cause initial disparity errors at the receiver with 8B/10B-coded data. The receiver must be able to tolerate these disparity errors.

Note: When receiving swapped symbols, the word alignment pattern must be byte-reversed accordingly to match the incoming byte-reversed data.

Rate Match FIFO

The Rate Match FIFO compensates for the small clock frequency differences between the upstream transmitter and the local receiver clocks.

In a link where the upstream transmitter and local receiver can be clocked with independent reference clock sources, the data can be corrupted by any frequency differences (in ppm count) when crossing the data from the recovered clock domain—the same clock domain as the upstream transmitter reference clock—to the local receiver reference clock domain.

The rate match FIFO is 20 words deep, which compensates for the small clock frequency differences of up to ± 300 ppm (600 ppm total) between the upstream transmitter and the local receiver clocks by performing symbol insertion or deletion, depending on the ppm difference on the clocks.

The rate match FIFO requires that the transceiver channel is in duplex configuration (both transmit and receive functions) and has a predefined 20-bit pattern (that consists of a 10-bit control pattern and a 10-bit skip pattern). The 10-bit skip pattern must be chosen from a code group with neutral disparity.

The rate match FIFO operates by looking for the 10-bit control pattern, followed by the 10-bit skip pattern in the data, after the word aligner has restored the word boundary. After finding the pattern, the rate match FIFO performs the following operations to ensure the FIFO does not underflow or overflow:

- Inserts the 10-bit skip pattern when the local receiver reference clock frequency is greater than the upstream transmitter reference clock frequency
- Deletes the 10-bit skip pattern when the local receiver reference clock frequency is less than the upstream transmitter reference clock frequency

The rate match FIFO supports operations in single-width mode. The 20-bit pattern can be user-defined for custom configurations. For protocol configurations, the rate match FIFO is automatically configured to support a clock rate compensation function as required by the following specifications:

- The PCIe protocol per clock tolerance compensation requirement, as specified in the PCI Express Base Specification 2.0 for Gen1 and Gen2 signaling rates
- The Gbps Ethernet (GbE) protocol per clock rate compensation requirement using an idle ordered set, as specified in Clause 36 of the IEEE 802.3 specification

In asynchronous systems, use independent reference clocks to clock the upstream transmitter and local receiver. Frequency differences in the order of a few hundred ppm can corrupt the data when latching from the recovered clock domain (the same clock domain as the upstream transmitter reference clock) to the local receiver reference clock domain.

The rate match FIFO deletes SKP symbols or ordered sets when the upstream transmitter reference clock frequency is higher than the local receiver reference clock frequency and inserts SKP symbols or ordered sets when the local receiver reference clock frequency is higher than the upstream transmitter reference clock frequency.

Related Information

- [Transceiver Custom Configurations in Cyclone V Devices](#)
- [Transceiver Protocol Configurations in Cyclone V Devices](#)

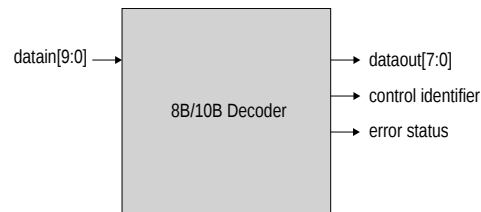
8B/10B Decoder

The receiver channel PCS datapath implements the 8B/10B decoder after the rate match FIFO. In configurations with the rate match FIFO enabled, the 8B/10B decoder receives data from the rate match FIFO. In configurations with the rate match FIFO disabled, the 8B/10B decoder receives data from the word aligner. The 8B/10B decoder supports operation in single- and double-width modes.

8B/10B Decoder in Single-Width Mode

In single-width mode, the 8B/10B decoder decodes the received 10-bit code groups into an 8-bit data and a 1-bit control identifier, in compliance with Clause 36 in the IEEE 802.3 specification. The 1-bit control identifier indicates if the decoded 8-bit code is a valid data or special control code. The decoded data is fed to the byte deserializer or the receiver phase compensation FIFO (if the byte deserializer is disabled).

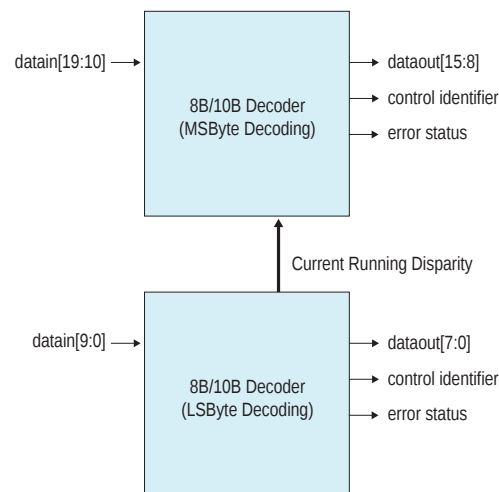
Figure 1-28: 8B/10B Decoder in Single-Width Mode



8B/10B Decoder in Double-Width Mode

In double-width mode, two 8B/10B decoders are cascaded to decode the 20-bit code groups into two sets of 8-bit data and two 1-bit control identifiers. When receiving the 20-bit code group, the 10-bit LSByte is decoded first and the ending running disparity is forwarded to the other 8B/10B decoder for decoding the 10-bit MSByte.

Figure 1-29: 8B/10B Decoder in Double-Width Mode



Control Code Group Detection

The 8B/10B decoder indicates whether the decoded 8-bit code group is a data or a control code group on the `rx_dataak` signal. If the received 10-bit code group is one of the 12 control code groups (`/Kx.y/`) specified in the IEEE802.3 specification, the `rx_dataak` signal is driven high. If the received 10-bit code group is a data code group (`/Dx.y/`), the `rx_dataak` signal is driven low.

Byte Deserializer

The FPGA fabric-transceiver interface frequency has an upper limit. In configurations that have a receiver PCS frequency greater than the upper limit stated, the parallel received data and status signals cannot be forwarded directly to the FPGA fabric because it violates this upper limit for the FPGA fabric-transceiver interface frequency. In such configurations, the byte deserializer is required to reduce the FPGA fabric-transceiver interface frequency to half while doubling the parallel data width.

Note: The byte deserializer is required in configurations that exceed the FPGA fabric-transceiver interface clock upper frequency limit. It is optional in configurations that do not exceed the FPGA fabric-transceiver interface clock upper frequency limit.

The byte deserializer supports operation in single- and double-width modes. The datapath clock rate at the input of the byte deserializer is twice the FPGA fabric-receiver interface clock frequency. After byte deserialization, the word alignment pattern may be ordered in the MSByte or LSByte position.

The data is assumed to be received as LSByte first—the least significant 8 or 10 bits in single-width mode or the least significant 16 or 20 bits in double-width mode.

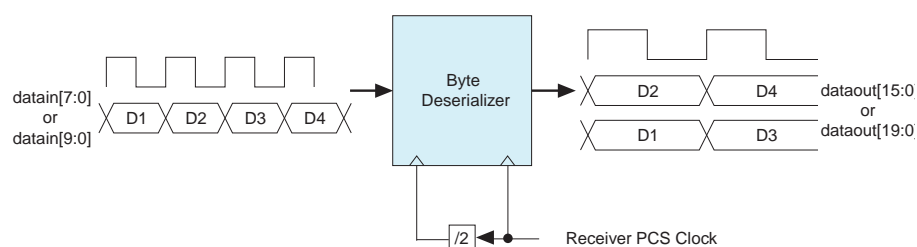
Table 1-27: Byte Deserializer Input Datapath Width Conversion

Mode	Byte Deserializer Input Datapath Width	Receiver Output Datapath Width
Single Width	8	16
	10	20
Double Width	16	32
	20	40

Byte Deserializer in Single-Width Mode

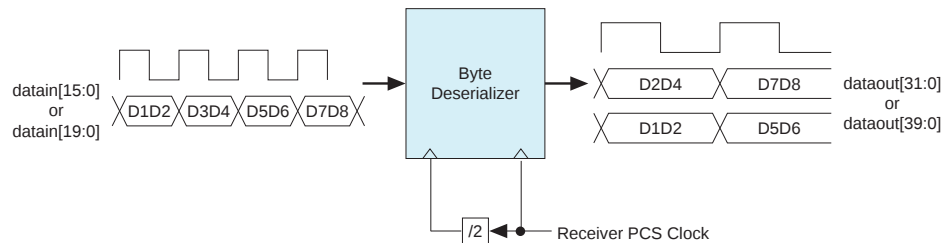
In single-width mode, the byte deserializer receives 8-bit wide data from the 8B/10B decoder or 10-bit wide data from the word aligner (if the 8B/10B decoder is disabled) and deserializes it into 16- or 20-bit wide data at half the speed.

Figure 1-30: Byte Deserializer in Single-Width Mode



Byte Deserializer in Double-Width Mode

In double-width mode, the byte deserializer receives 16-bit wide data from the 8B/10B decoder or 20-bit wide data from the word aligner (if the 8B/10B decoder is disabled) and deserializes it into 32- or 40-bit wide data at half the speed.

Figure 1-31: Byte Deserializer in Double-Width Mode

Byte Ordering

When you enable the byte deserializer, the output byte order may not match the originally transmitted ordering. For applications that require a specific pattern to be ordered at the LSByte position of the data, byte ordering restores the proper byte order of the byte-deserialized data before forwarding it to the FPGA fabric.

Byte ordering operates by inserting a predefined pad pattern to the byte-deserialized data if the predefined byte ordering pattern found is not in the LSByte position.

Byte ordering requires the following:

- A receiver with the byte deserializer enabled
- A predefined byte ordering pattern that must be ordered at the LSByte position of the data
- A predefined pad pattern

Byte ordering supports operation in single- and double-width modes. Both modes support operation in word aligner-based and manual ordering modes.

Byte Ordering in Single-Width Mode

Byte ordering is supported only when you enable the byte deserializer.

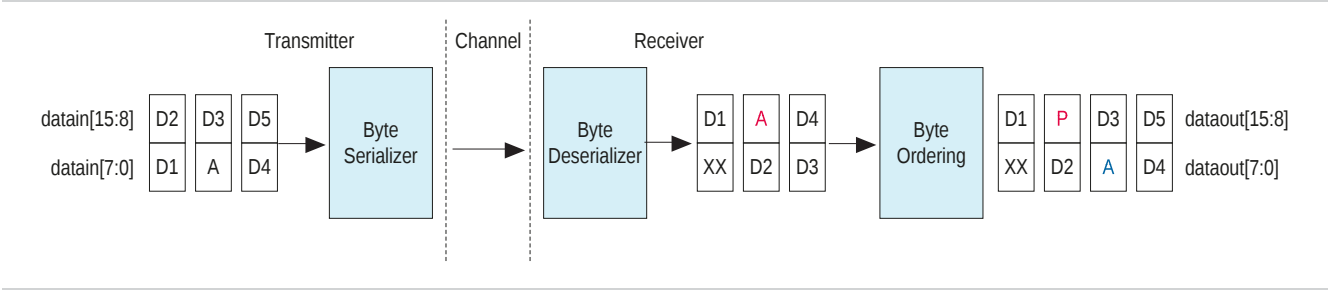
Table 1-28: Byte Ordering Operation in Single-Width Mode

PMA-PCS Interface Width	FPGA Fabric-Transceiver Interface Width	8B/10B Decoder	Byte Ordering Pattern Length	Pad Pattern Length
8 bits	16 bits	Disabled	8 bits	8 bits
10 bits	16 bits	Enabled	9 bits ⁽³⁾	9 bits ⁽³⁾
	20 bits	Disabled	10 bits	10 bits

⁽³⁾ The MSB of the 9-bit pattern represents the 1-bit control identifier of the 8B/10B-decoded data. The lower 8 bits represent the 8-bit decoded code.

Figure 1-32: Byte Ordering Operation Example in Single-Width Mode

An example of a byte ordering operation in single-width mode (8-bit PMA-PCS interface width) where A is the predefined byte ordering pattern and P is the predefined pad pattern.



Byte Ordering in Double-Width Mode

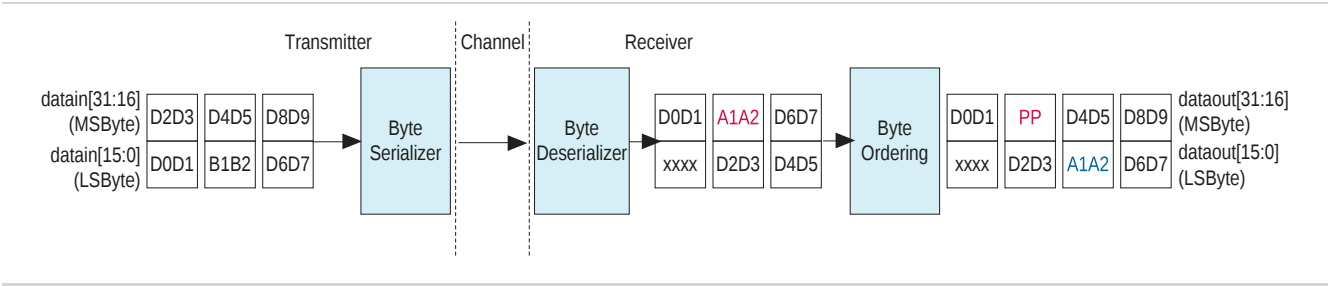
Byte ordering is supported only when you enable the byte deserializer.

Table 1-29: Byte Ordering Operation in Double-Width Mode

PMA-PCS Interface Width	FPGA Fabric-Transceiver Interface Width	8B/10B Decoder	Byte Ordering Pattern Length	Pad Pattern Length
16 bits	32 bits	Disabled	8 or 16 bits	8 bits
20 bits	32 bits	Enabled	9 ⁽⁴⁾ or 18 bits ⁽⁵⁾	9 bits ⁽⁴⁾
	40 bits	Disabled	10 or 20 bits	10 bits

Figure 1-33: Byte Ordering Operation Example in Double-Width Mode

An example of a byte ordering operation in double-width mode (16-bit PMA-PCS interface width) where A1A2 is the predefined byte ordering pattern and P is the predefined pad pattern.



Word Aligner-Based Ordering Mode

In word aligner-based ordering mode, the byte ordering operation is controlled by the word aligner synchronization status signal, rx_syncstatus.

After a rising edge on the rx_syncstatus signal, byte ordering looks for the byte ordering pattern in the byte-deserialized data.

⁽⁴⁾ The MSB of the 9-bit pattern represents the 1-bit control identifier of the 8B/10B-decoded data. The lower 8 bits represent the 8-bit decoded code.
⁽⁵⁾ The 18-bit pattern consists of two sets of 9-bit patterns, individually represented as in the previous note.

When the first data byte that matches the byte ordering pattern is found, the byte ordering performs the following operations:

- If the pattern is not in the LSByte position—byte ordering inserts the appropriate number of pad patterns to push the byte ordering pattern to the LSByte position and indicates the byte alignment.
- If the pattern is in the LSByte position—byte ordering indicates the byte alignment.

Any byte misalignment found thereafter is ignored unless another rising edge on the `rx_syncstatus` signal, indicating resynchronization, is observed.

Manual Ordering Mode

In manual ordering mode, the byte ordering operation is controlled using the `rx_enabyteord` signal.

A rising edge on the `rx_enabyteord` signal triggers byte ordering to look for the byte ordering pattern in the byte-deserialized data.

When the first data byte that matches the byte ordering pattern is found, the byte ordering performs the following operations:

- If the pattern is not in the LSByte position—byte ordering inserts the appropriate number of pad patterns to push the byte ordering pattern to the LSByte position and indicates the byte alignment.
- If the pattern is in the LSByte position—byte ordering indicates the byte alignment.

Any byte misalignment found thereafter is ignored unless another rising edge on the `rx_enabyteord` signal is observed.

Receiver Phase Compensation FIFO

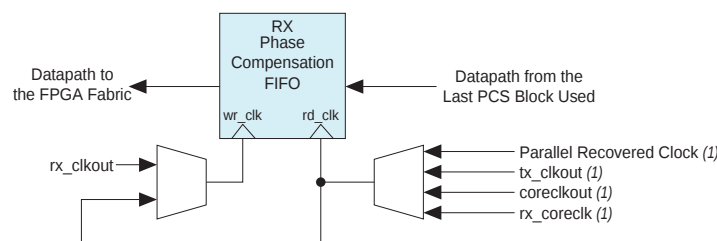
The receiver phase compensation FIFO is four words deep and interfaces the status and data signals between the receiver PCS and the FPGA fabric or the PCIe hard IP block.

The low-speed parallel clock feeds the write clock, while the FPGA fabric interface clock feeds the read clock. The clocks must have 0 ppm difference in frequency or a receiver phase compensation FIFO underrun or overflow condition may result.

The FIFO supports the following operations:

- Phase compensation mode with various clocking modes on the read clock and write clock
- Registered mode with only one clock cycle of datapath latency

Figure 1-34: Receiver Phase Compensation FIFO



Note:

1. These clocks may have been divided by 2 if you used a byte deserializer.

Related Information

Transceiver Clocking in Cyclone V Devices.

Registered Mode

To eliminate the FIFO latency uncertainty for applications with stringent datapath latency uncertainty requirements, bypass the FIFO functionality in registered mode to incur only one clock cycle of datapath latency when interfacing the transmitter channel to the FPGA fabric. Configure the FIFO to registered mode when interfacing the transmitter channel to the FPGA fabric or PCIe hard IP block to reduce datapath latency. In registered mode, the low-speed parallel clock that is used in the transmitter PCS clocks the FIFO.

Channel Bonding

The high-speed serial clock and low-speed parallel clock skew between channels and unequal latency in the transmitter phase compensation FIFO contribute to transmitter channel-to-channel skew. Bonded transmitter datapath clocking provides low channel-to-channel skew when compared with non-bonded channel configurations.

- Bonded channel configurations—the serial clock and parallel clock for all bonded channels are generated by the transmit PLL and central clock divider, resulting in lower channel-to-channel clock skew.

The transmitter phase compensation FIFO in all bonded channels share common pointers and control logic generated in the central clock divider, resulting in equal latency in the transmitter phase compensation FIFO of all bonded channels. The lower transceiver clock skew and equal latency in the transmitter phase compensation FIFOs in all channels provide lower channel-to-channel skew in bonded channel configurations.

- Non-bonded channel configurations—the parallel clock in each channel are generated independently by its local clock divider, resulting in higher channel-to-channel clock skew.

The transmitter phase compensation FIFO in each non-bonded channel has its own pointers and control logic that can result in unequal latency in the transmitter phase compensation FIFO of each channel. The higher transceiver clock skew and unequal latency in the transmitter phase compensation FIFO in each channel can result in higher channel-to-channel skew.

Related Information

[*Transceiver Clocking in Cyclone V Devices*](#)

PLL Sharing

In a Quartus II design, you can merge two different protocol configurations to share the same CMU PLL resources. These configurations must fit in the same transceiver bank and the input `refclk` and PLL output frequencies must be identical.

Document Revision History

The revision history for this chapter.

Table 1-30: Document Revision History

Date	Version	Changes
		<ul style="list-style-type: none"> Updated the <i>6.144 Gbps CPRI Support Capability in GT Devices</i> section.
May 2013	2013.05.06	<ul style="list-style-type: none"> Added link to the known document issues in the Knowledge Base Updated the <i>Transceiver Architecture in Cyclone V Devices</i> section. Updated the <i>Architecture Overview</i> section. Updated the <i>Automatic Lock Mode</i> section. Updated the <i>Transmitter Buffer</i> section. Updated Table 1-2. Updated Table 1-5. Updated the <i>Rate Match FIFO</i> section. Updated the <i>Transceiver Banks</i> section. Added the <i>Channel Variants</i> section. Updated the <i>Transceiver Channel Architecture</i> section. Updated Figure 1-7. Updated the <i>Transmitter PLL</i> section. Updated the <i>Channel PLL Architecture</i> section. Updated the <i>Channel PLL as CDR PLL</i> section. Updated the <i>CDR PLL in Automatic Lock Mode</i> section. Added the <i>CDR PLL in Manual Lock Mode</i> section. Updated the <i>Channel PLL as a CMU PLL</i> section. Added the <i>fPLL as a Transmitter PLL</i> section. Updated the <i>Clock Divider</i> section. Updated the <i>Receiver PMA Datapath</i> section. Updated the <i>Receiver Buffer</i> section. Updated the <i>Programmable Receiver V_{CM}</i> section. Updated the <i>Transmitter PMA Datapath</i> section. Added the <i>Bit Reversal</i> section. Updated the <i>Transmitter Buffer</i> section. Updated the <i>Transmitter Buffer Features and Capabilities</i> section. Updated the <i>Transmitter Protocol Specific</i> section. Updated the <i>Calibration Block</i> section. Updated the <i>PCS Architecture</i> section. Updated the <i>Transmitter Phase Compensation FIFO</i> section. Added the <i>Registered Mode</i> section. Updated the <i>Byte Serializer</i> section. Updated the <i>8B/10B Encoder in Single-Width Mode</i> section.

Date	Version	Changes
		<ul style="list-style-type: none">• Updated the <i>Word Aligner</i> section.• Updated the <i>Word Aligner Options and Behaviors</i> section.• Updated the <i>Word Aligner in Manual Alignment Mode</i> section.• Updated the <i>Programmable Run-Length Violation Detection</i> section.• Updated the <i>Rate Match FIFO</i> section.• Updated the <i>8B/10B Decoder</i> section.• Updated the <i>Byte Deserializer</i> section.• Updated the <i>Byte Ordering in Single-Width Mode</i> section.• Updated the <i>Byte Ordering in Double-Width Mode</i> section.• Added the <i>Word Aligner-Based Ordering Mode</i> section.• Added the <i>Manual Ordering Mode</i> section.• Updated the <i>Receiver Phase Compensation FIFO</i> section.• Updated the <i>Channel Bonding</i> section.• Updated the <i>PLL Sharing</i> section.
December 2012	2012.12.03	Clarified note to Figure 1-6 to indicate only certain transceiver channels support interfacing to PCIe. Removed DC-Coupling information from Transmitter Buffer Features and Capabilities and PMA Receiver Buffer.
November 2012	2012.11.19	Reorganized content and updated template
June 2012	1.1	Added in contents of Transceiver Basics for Cyclone V Devices. Updated “Architecture Overview”, “PMA Architecture” and “PCS Architecture” sections. Updated Table 1–11. Updated Figure 1–36.

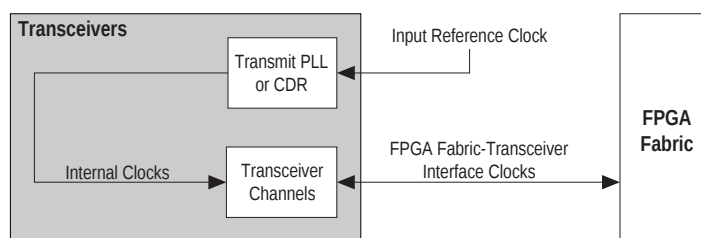
2013.05.06

CV-53002

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This chapter provides information about the Cyclone® V transceiver clocking architecture. The chapter describes the clocks that are required for operation, internal clocking architecture, and clocking options when the transceiver interfaces with the FPGA fabric.

Figure 2-1: Transceiver Clocking Architecture Overview



Related Information

[Cyclone V Device Handbook: Known Issues](#)

Lists the planned updates to the *Cyclone V Device Handbook* chapters.

Input Reference Clocking

This section describes how the reference clock for the transmitter PLL and CDR is provided to generate the clocks required for transceiver operation.

Table 2-1: Input Reference Clock Sources

Sources	Transmitter PLL	CDR	Jitter Performance ⁽⁶⁾
	CMU PLL		
Dedicated <code>refclk</code> pin	Yes	Yes	1
REFCLK network	Yes	Yes	2
Dual-purpose RX / <code>refclk</code> pin	Yes	Yes	3
Fractional PLL	Yes	Yes	4

⁽⁶⁾ The lower number indicates better jitter performance.

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Sources	Transmitter PLL	CDR	Jitter Performance ⁽⁶⁾
	CMU PLL		
Generic CLK pin	No	No	5
Core clock network (GCLK, RCLK, PCLK)	No	No	6

Dedicated Reference Clock Pins

Cyclone V devices have one dedicated reference clock (`refclk`) pin for each bank of three transceiver channels.

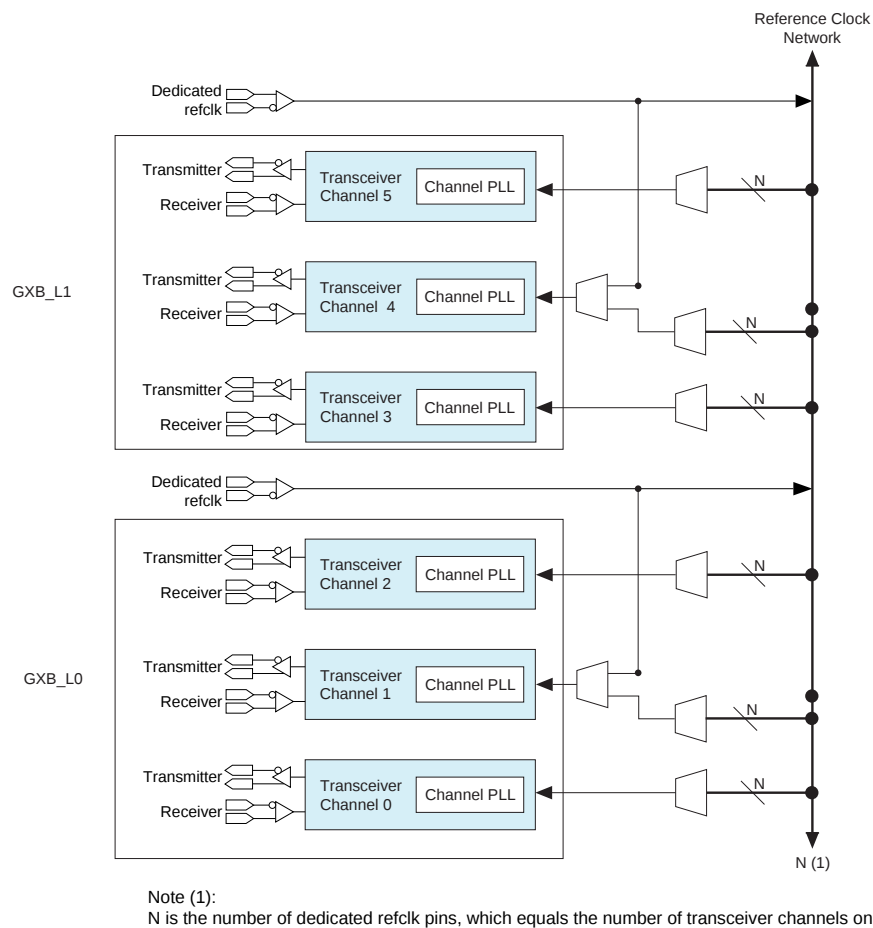
The dedicated reference clock pins drive the channel PLL in channel 1 or 4 directly. This option provides the best quality of input reference clock to the transmitter PLL and CDR.

Note: For specifications about the input frequency supported by the `refclk` pins, refer to the *Cyclone V Device Datasheet*.

As shown in the following figure the dedicated `refclk` pin direct connection to the channel PLL (which can be configured either as a CMU PLL or CDR) is only available in channel 1 of a transceiver bank and channel 4 of the neighboring transceiver bank.

⁽⁶⁾ The lower number indicates better jitter performance.

Figure 2-2: Input Reference Clock Sources for Transceiver Channels



Related Information

[Cyclone V Device Datasheet](#)

Dedicated refclk Using the Reference Clock Network

Designs that use multiple channel PLLs with the same clock frequency can use the same dedicated `refclk` pin. Each dedicated `refclk` pin can drive any channel PLL (CMU PLL/CDR) and the fractional PLL through the reference clock network.

Figure 2-2 shows the input reference clock sources for six channel PLLs across two transceiver banks. For six transceiver channels, the total number of clock lines in the reference clock network is 2 ($N = 6/3$).

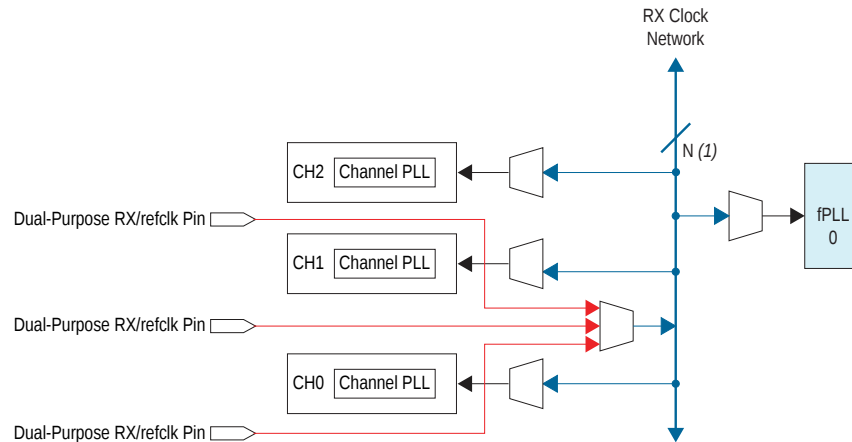
Dual-Purpose RX/refclk Pins

When not used as a receiver, an RX differential pair can be used as an additional input reference clock source.

The clock from the RX pins feed the RX clock network that spans all the channels on one side of the device. Only one RX differential pair for every three channels can be used as input reference clock at a time. The following figure shows the use of dual-purpose RX/refclk differential pin as input reference clock source and the RX clock network.

- Note:**
- An RX differential pair from another bank can be used as an input reference clock pin on the same side of the device.
 - refclk switching cannot be performed when dual-purpose RX differential pins are used refclk pins.

Figure 2-3: Dual-Purpose RX/refclk Pin as an Input Reference Clock



Note (1): N is the number of transceiver channels on a side divided by 3.

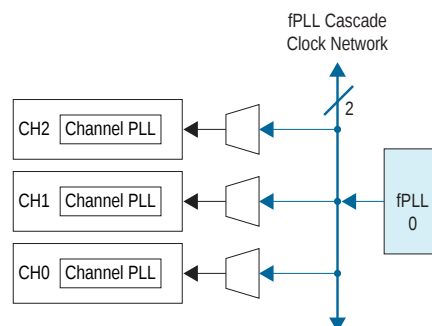
Fractional PLL (fPLL)

The fPLL clock output can be used as input reference clock source to transmitter PLL or CDR.

Cascading the fPLL to transmitter PLL or CDR enables you to use an input reference clock that is not supported by the transmitter PLL or CDR. The fPLL synthesizes a supported input reference clock for the transmitter PLL or CDR.

A fPLL is available for each bank of three transceiver channels. Each fPLL drives one of two fPLL cascade clock network lines that can provide an input reference clock to any transmitter PLL or CDR on the same side of a device. fPLLs support fractional and integer modes. The fractional mode allows you to synthesize a clock of any supported frequency, and the integer mode allows you to synthesize an output clock that is an integer multiple or factor of the input clock. For example, fPLLs allow you to take a 100 MHz clock and synthesize a clock of 50 or 200 MHz in integer mode, or 614.4 MHz in fractional mode.

Figure 2-4: fPLL Clock Output as Input Reference Clock



Internal Clocking

This section describes the clocking architecture internal to Cyclone V transceivers.

Different physical coding sublayer (PCS) configurations and channel bonding options result in various transceiver clock paths.

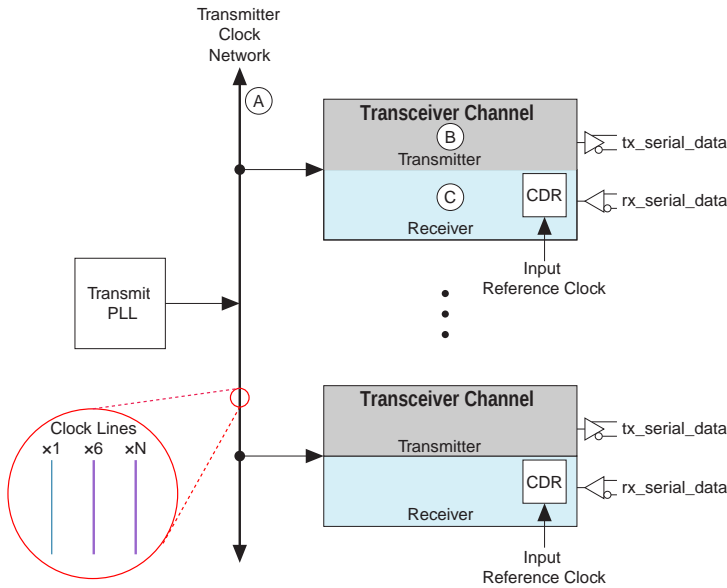
Note: The Quartus II software automatically performs the internal clock routing based on the transceiver configuration that you select.

The labels listed in the following table and figure mark the three sections of the transceiver internal clocking.

Table 2-2: Internal Clocking Subsections

Label	Scope	Description
A	Transmitter Clock Network	Clock distribution from transmitter PLLs to channels
B	Transmitter Clocking	Clocking architecture within transmitter channel datapath
C	Receiver Clocking	Clocking architecture within receiver channel datapath

Figure 2-5: Internal Clocking



Transmitter Clock Network

The transmitter PLL is comprised of the CMU PLL. All CMU PLLs are identical, but the usage varies depending on channel location due to the availability of access to the clock distribution network.

Table 2-3: Usage Capability of Each CMU PLL Within Two Transceiver Banks

CMU PLL Location in Two Transceiver Banks	Clock Network Access	Usage Capability
CH 0	No	Clock transmitter within same channel only
CH 1	Yes	Clock transmitter within same channel only and other channels via clock network
CH 2	No	Clock transmitter within same channel only
CH 3	No	Clock transmitter within same channel only
CH 4	Yes	Clock transmitter within same channel and other channels via clock network
CH 5	No	Clock transmitter within same channel only

The transmitter clock network routes the clock from the transmitter PLL to the transmitter channel. As shown in the previous figure, the transmitter clock network routes the clock from the transmit PLL to the transmitter channel. A clock divider provides two clocks to the transmitter channel:

- Serial clock—high-speed clock for the serializer
- Parallel clock—low-speed clock for the serializer and the PCS

Cyclone V transceivers support non-bonded and bonded transceiver clocking configurations:

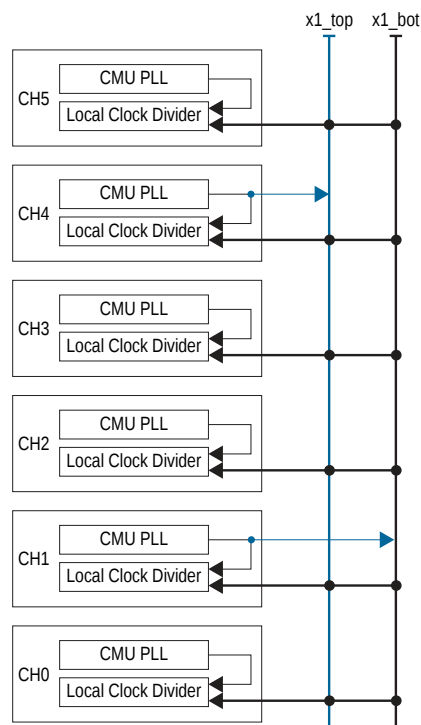
- Non-bonded configuration—Only the serial clock from the transmit PLL is routed to the transmitter channel. The clock divider of each channel generates the local parallel clock.
- Bonded configuration—Both the serial clock and parallel clock are routed from the central clock divider in channel 1 or 4 to the bonded transmitter channels.

The transmitter clock network is comprised of x1 (x1 and x1_fPLL), x6 and xN clock lines.

Table 2-4: Characteristics of x1, x6, and xN Clock Lines

Characteristics	x1	x6	xN
Clock Source	CMU PLL from CH 1 or CH 4 in two banks (serial clock only)	Central clock divider from CH 1 or Ch 4 in two banks (serial and parallel clock)	x6 clock lines (serial and parallel clock)
Maximum Data Rate (Gbps)	5.0 (GT and ST), 3.125 (GX and SX)	5.0 (GT and ST), 3.125 (GX and SX)	3.125
Clock Line Span	Within two transceiver banks	Within two transceiver banks	Across all channels on the same side of the device
Non-bonded Configuration	Yes	Yes	Yes
Bonded Configuration	No	Yes	Yes

Figure 2-6: x1 Clock Line Architecture

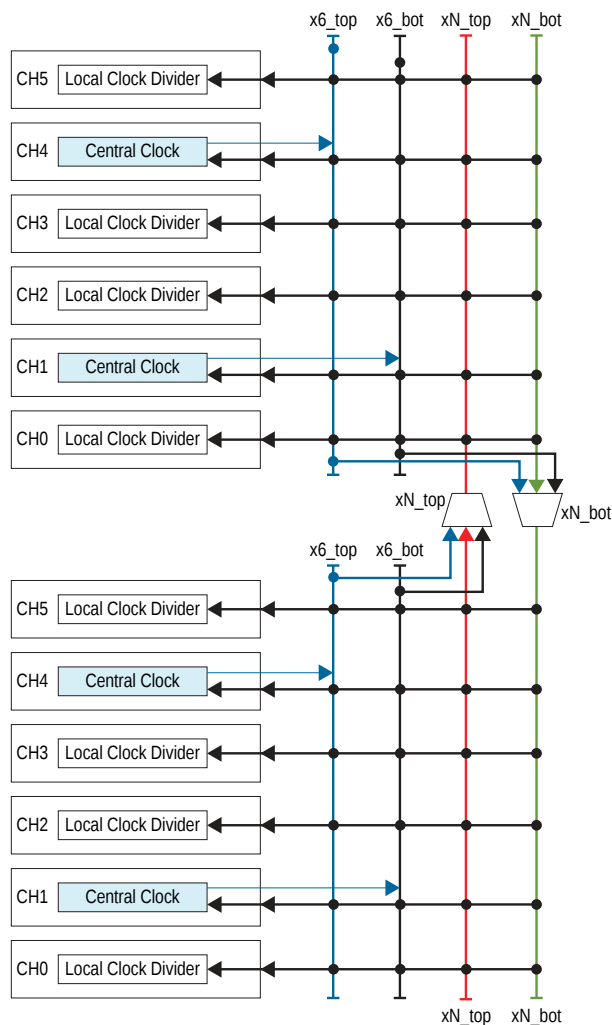


Note: All clock lines shown in this figure carry the serial clock only.

The x1 clock lines are driven by serial clocks of CMU PLLs from channels 1 and 4. The serial clock in the x1 clock line is then distributed to the local and central clock dividers of every channel within both the neighboring transceiver banks.

Note: When you configure the channel PLL as a CMU PLL to drive the local clock divider, or the central clock divider of its own channel, you cannot use the channel PLL as a CDR. Without a CDR, you can use the channel only as a transmitter channel.

Figure 2-7: x6 and xN Clock Line Architecture



Note: All the clock lines shown in this figure carry both the serial and parallel clocks.

The x6 clock lines are driven by serial and parallel clocks from the central clock divider in channels 1 and 4. For channels 0 to 5 within the 2 transceiver banks, the serial and parallel clocks in the x6 clock line are then distributed to every channel in both the transceiver banks.

The xN clock lines extend the clocking reach of the x6 clock line to all channels on the same side of the device. To reach a xN clock line, the clocks must be provided on the x6 clock line. The serial and parallel clocks in the x6 clock line are distributed to every channel within the two transceiver banks. The serial and parallel clocks are distributed to other channels beyond the two banks or the six channels using the xN clock line.

In bonded configurations, serial and parallel clocks from the x6 or xN clock lines are received by the clock divider of every bonded channel and fed directly to the serializer. In a non-bonded configuration, the clock divider of every non-bonded channel receives the serial clock from the x6 or xN clock lines and generates the individual parallel clock to the serializer.

Note: In a bonded configuration, bonded channels must be placed contiguously without leaving a gap between the channels, except when the gap channel is a CMU PLL used for the bonded channels.

The contiguous channels may span across many banks for bonded mode. For example, in x8 bonding, the bonded channels may span across 3 to 4 banks with the condition that there must be no gap between the channels except when the gap is due to the channel used for CMU PLL.

Transmitter Clocking

Transmitter (TX) clocking refers to the clocking architecture that is internal to the TX channel of a transceiver.

As shown in the following figure, the clock divider provides the serial clock to the serializer, and the parallel clock to the serializer and TX PCS. When the byte serializer is not used, the parallel clock clocks all the blocks up to the read side of the TX phase compensation FIFO. For configurations with the byte serializer, the parallel clock is divided by a factor of two for the byte serializer and the read side of the TX phase compensation FIFO. The read side clock of the TX phase compensation FIFO is also forwarded to the FPGA fabric to interface the FPGA fabric with the transceiver.

Figure 2-8: Clocking Architecture for Transmitter PCS and PMA Configuration

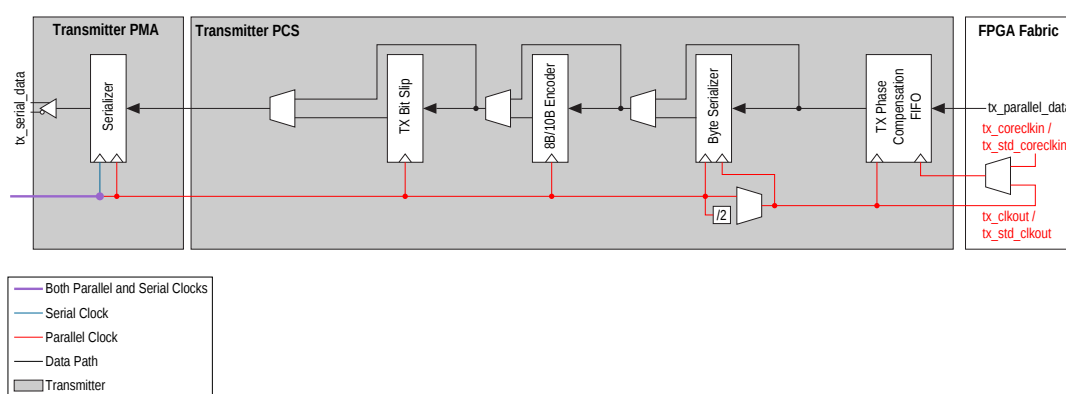


Table 2-5: Clock Sources for All TX PCS Blocks

PCS Block	Side	Clock Source
TX Phase Compensation FIFO	Write	FPGA fabric write clock, driven either by tx_clkout or tx_coreclk
	Read	Parallel clock (divided). Clock forwarded to FPGA fabric as tx_clkout
Byte Serializer	Write	Parallel clock (divided) either by factor of 1 (not enabled), or factor of 2 (enabled)
	Read	Parallel clock
8B/10B Encoder	—	Parallel clock
TX Bit Slip	—	Parallel clock

Non-Bonded Channel Configurations

This section describes the clock path for non-bonded configurations.

The following table describes the clock path for non-bonded configuration with the CMU PLL and fPLL as TX PLL using various clock lines.

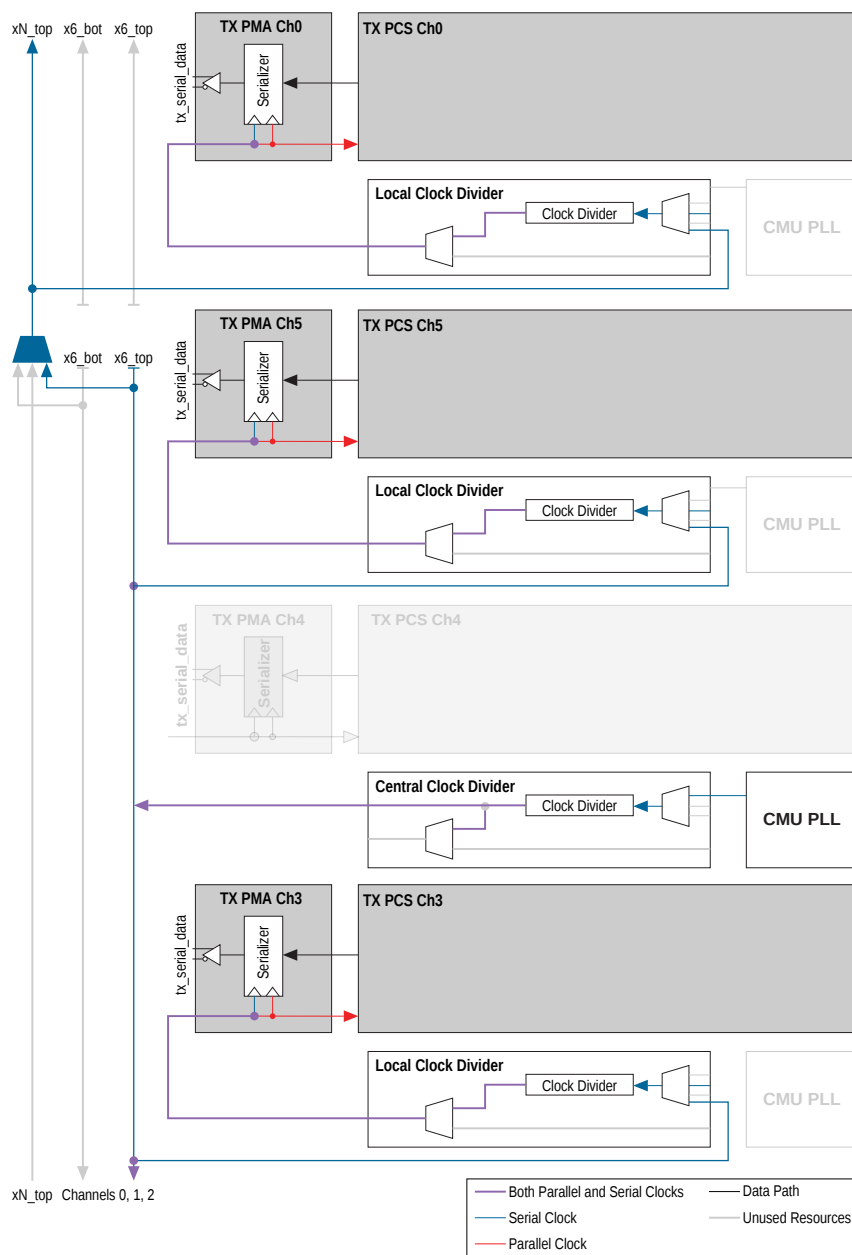
Table 2-6: Clock Path for Non-Bonded Configurations

Clock Line	Transmitter PLL	Clock Path
x1	CMU	CMU PLL » x1 » individual clock divider » serializer
x6, xN	CMU	CMU PLL » central clock divider » x6 » xN » individual clock divider » serializer ⁽⁷⁾

⁽⁷⁾ Non-bonded channels within the neighboring two banks or within the six channels of TX PLL are driven by clocks from x6 clock line. Channels in other banks outside the 6 channels are driven by the xN clock line.

Figure 10 illustrates the TX PCS and TX PMA connections for Channels 3, 4, and 5. The diagram shows three horizontal sections, each representing a channel. Each section contains a TX PMA block and a TX PCS block. The TX PMA block includes a Serializer and a Multiplexer. The TX PCS block is a large gray rectangle. A Local Clock Divider and a Central Clock Divider are shown below the TX PCS blocks. The CMU PLL is shown on the right. A vertical line on the left is labeled 'x1_top' and 'Channels 0, 1, 2'. A legend at the bottom explains the line types: Both Parallel and Serial Clocks (purple), Serial Clock (blue), Parallel Clock (red), Data Path (black), and Unused Resources (gray).

Figure 2-10: Three Non-Bonded Transmitter Channels Driven by CMU PLL using x6 and xN Clock Lines Across Multiple Transceiver Banks



Bonded Channel Configurations

This section describes the clock path for bonded configurations.

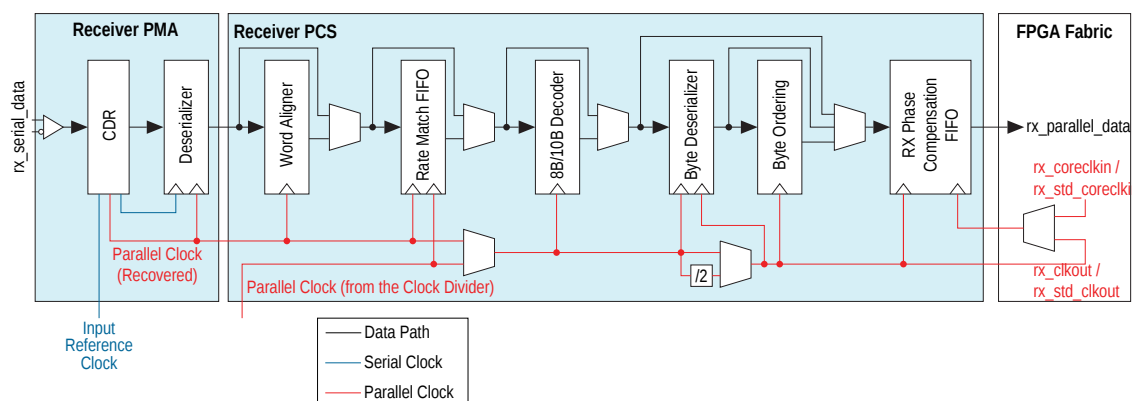
The following table describes the clock path for bonded configurations with the CMU PLL as TX PLL using various clock lines.

Note: When a channel PLL is configured as a CMU PLL to drive the local clock divider or the central clock divider of its own channel, the channel PLL cannot be used as a CDR. Without a CDR, the channel can be used only as a transmitter.

Receiver Clocking

This section describes receiver clocking, which is the clocking architecture internal to the receiver channel of a transceiver.

Figure 2-12: Clocking Architecture for Receiver PCS and PMA Configuration



The CDR in the PMA of each channel recovers the serial clock from the incoming data and generates the parallel clock (recovered) by dividing the serial clock (recovered). The deserializer uses both clocks. The receiver PCS can use the following clocks depending on the configuration of the receiver channel:

- Parallel clock (recovered) from the CDR in the PMA
- Parallel clock from the clock divider that is used by the channel's transmitter PCS

Table 2-8: Clock Sources for All Receiver PCS Blocks

Block	Side	Clock Source
Word aligner	-	Parallel clock (recovered)
Rate match FIFO	Write	Parallel clock (recovered)
	Read	Parallel clock from the clock divider
8B/10B decoder	-	<ul style="list-style-type: none"> • Rate match FIFO is not used-Parallel clock (recovered) • Rate match FIFO is used-Parallel clock from the clock divider
Byte deserializer	Write	<ul style="list-style-type: none"> • Rate match FIFO is not used-Parallel clock (recovered) • Rate match FIFO is used-Parallel clock from the clock divider
	Read	Divided down version of the write side clock depending on the deserialization factor of 1 or 2, also called the parallel clock (divided)
Byte ordering	-	Parallel clock (divided)

Block	Side	Clock Source
Receiver (RX) phase compensation FIFO	Write	Parallel clock (divided). This clock is also forwarded to the FPGA fabric.
	Read	Clock sourced from the FPGA fabric

Receiver Non-Bonded Channel Configurations

This section describes the receiver non-bonded channel configurations.

The receiver clocking in non-bonded mode varies depending on whether the rate match FIFO is enabled. When the rate match FIFO is not enabled, the receiver PCS in every channel uses the parallel recovered clock. When the rate match FIFO is enabled, the receiver PCS in every channel uses both the parallel recovered clock and parallel clock from the clock divider.

Figure 2-13: Three Non-Bonded Receiver Channels without Rate Match FIFO Enabled

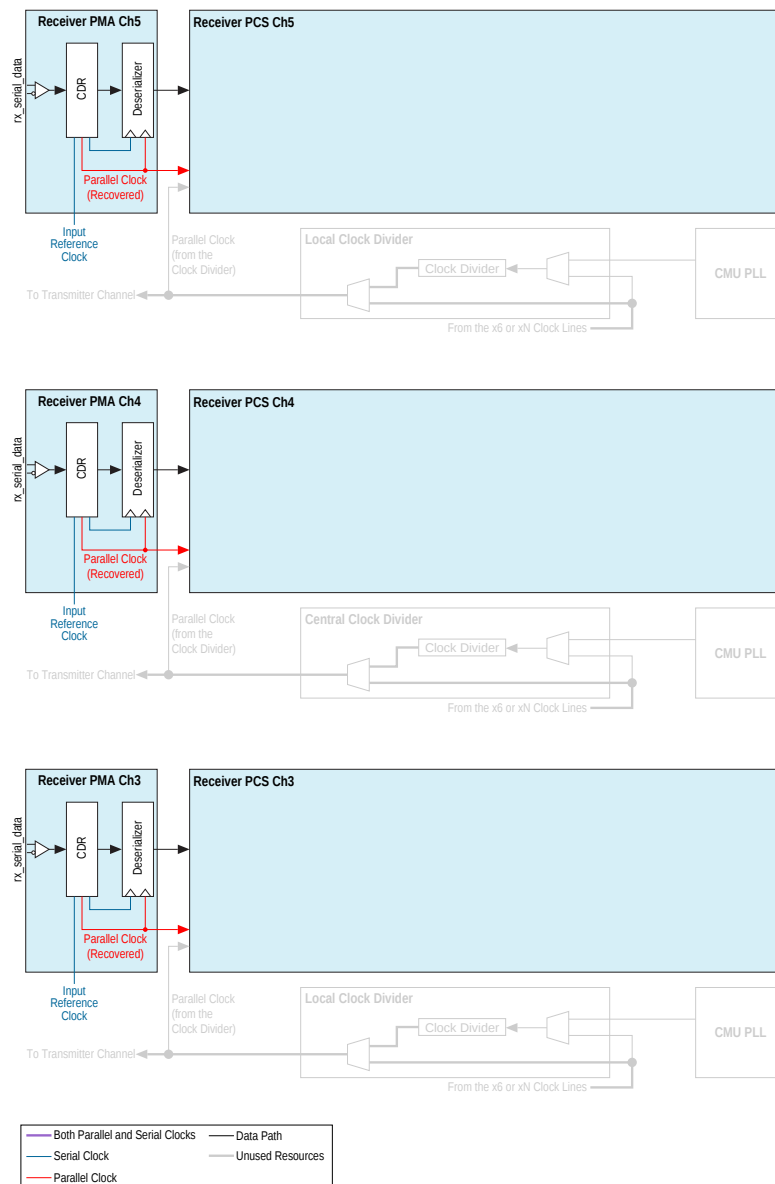
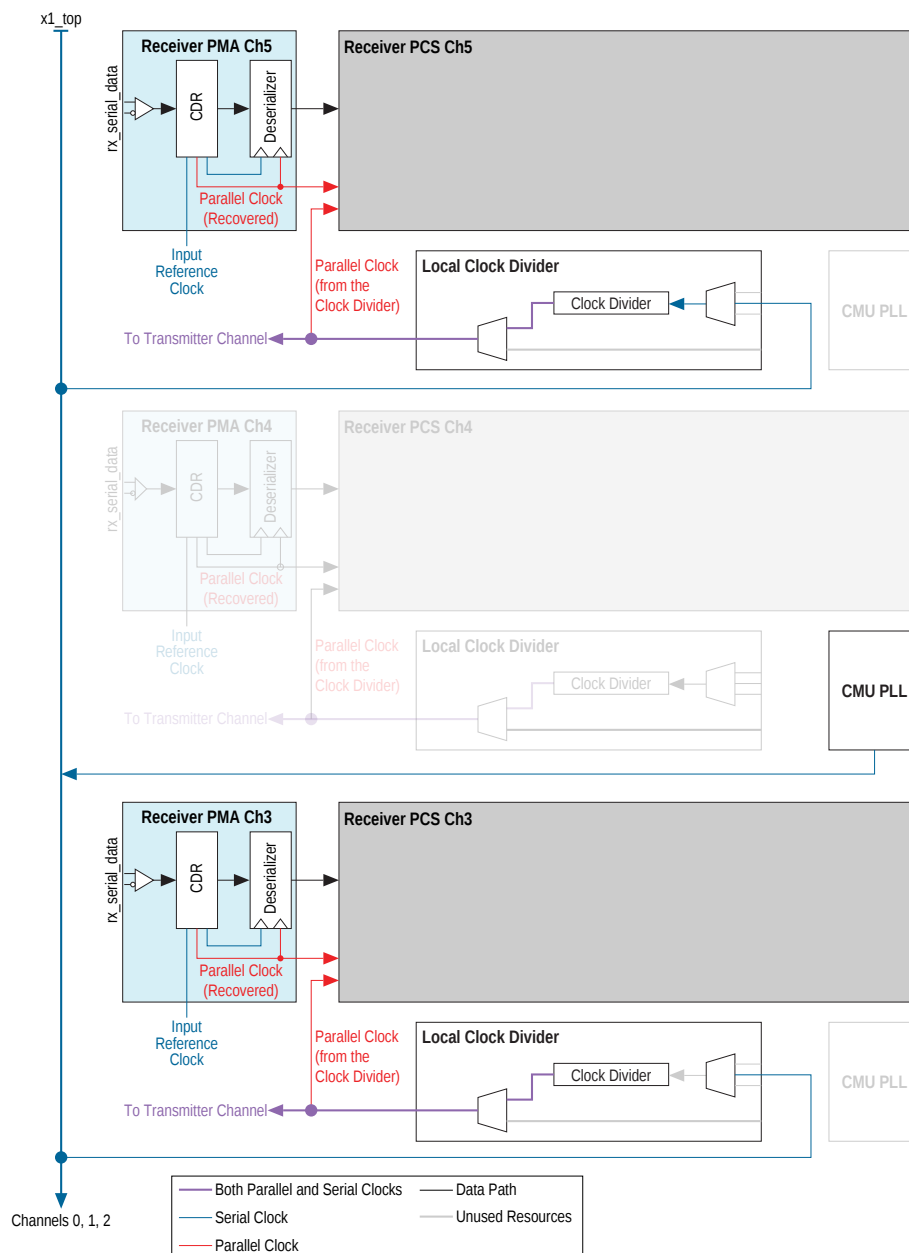


Figure 2-14: Two Non-Bonded Receiver Channels with Rate Match FIFO Enabled

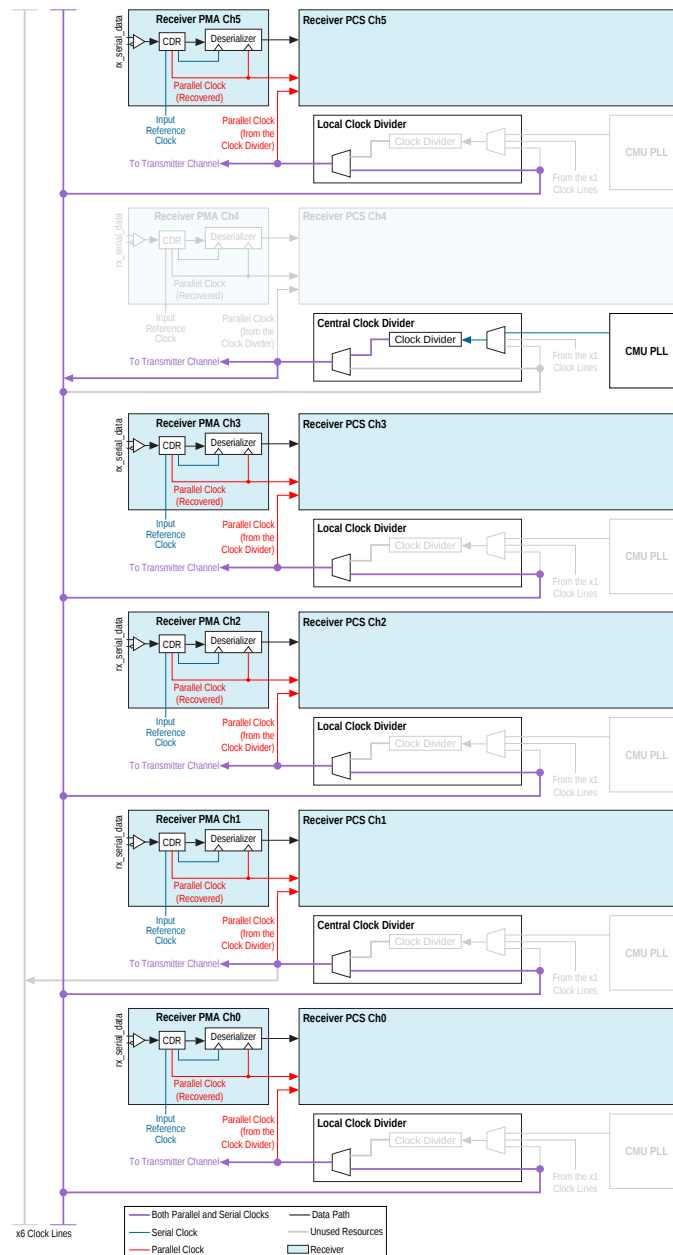


Receiver Bonded Channel Configurations

Receiver channels can only be bonded in configurations where rate match FIFOs are enabled. When bonded, the receiver PCS requires the parallel clock (recovered) and the parallel clock from the central clock divider in channel 1 or 4.

Note: For more information about the clocking scheme used in different configurations, refer to the *Transceiver Protocol Configurations in Cyclone V Devices* and *Transceiver Custom Configurations in Cyclone V Devices* chapters.

Figure 2-15: Five Bonded Receiver Channels with Rate Match FIFO Enabled



Related Information

[Transceiver Protocol Configurations in Cyclone V Devices](#)

[Transceiver Custom Configurations in Cyclone V Devices](#)

FPGA Fabric–Transceiver Interface Clocking

This section describes the clocking options available when the transceiver interfaces with the FPGA fabric.

The FPGA fabric-transceiver interface clocks consist of clock signals from the FPGA fabric to the transceiver blocks and clock signals from the transceiver blocks to the FPGA fabric. These clock resources use the clock networks in the FPGA core, including the global (GCLK), regional (RCLK), and periphery (PCLK) clock networks.

The FPGA fabric–transceiver interface clocks can be subdivided into the following three categories:

- Input reference clocks—Can be an FPGA fabric–transceiver interface clock. This may occur when the FPGA fabric-transceiver interface clock is forwarded to the FPGA fabric, where it can then clock logic.
- Transceiver datapath interface clocks—Used to transfer data, control, and status signals between the FPGA fabric and the transceiver channels. The transceiver channel forwards the `tx_clkout` signal to the FPGA fabric to clock the data and control signals into the transmitter. The transceiver channel also forwards the recovered `rx_clkout` clock (in configurations without the rate matcher) or the `tx_clkout` clock (in configurations with the rate matcher) to the FPGA fabric to clock the data and status signals from the receiver into the FPGA fabric.
- Other transceiver clocks—The following transceiver clocks form a part of the FPGA fabric–transceiver interface clocks:
 - `mgmt_clk`—Avalon[®]-MM interface clock used for controlling the transceivers, dynamic reconfiguration, and calibration
 - `fixed_clk`—the 125 MHz fixed-rate clock used in the PCIe (PIPE) receiver detect circuitry



Table 2-9: FPGA Fabric–Transceiver Interface Clocks

Clock Name	Clock Description	Interface Direction	FPGA Fabric Clock Resource Utilization
tx_pll_refclk, rx_cdr_refclk	Input reference clock used for clocking logic in the FPGA fabric	Transceiver-to-FPGA fabric	GCLK, RCLK, PCLK
tx_clkout, tx_pma_clkout	Clock forwarded by the transceiver for clocking the transceiver datapath interface		
rx_clkout, rx_pma_clkout	Clock forwarded by the receiver for clocking the receiver datapath interface		
tx_coreclk	User-selected clock for clocking the transmitter datapath interface	FPGA fabric-to-transceiver	
rx_coreclk	User-selected clock for clocking the receiver datapath interface		
fixed_clk	PCIe receiver detect clock		
mgmt_clk ⁽⁹⁾	Avalon-MM interface management clock		

Note: For more information about the GCLK, RCLK, and PCLK resources available in each device, refer to the *Clock Networks and PLLs in Cyclone V Devices* chapter.

⁽⁹⁾ The mgmt_clk is a free-running clock that is not derived from the transceiver blocks.

Related Information**Clock Networks and PLLs in Cyclone V Devices**

Transceiver Datapath Interface Clocking

There are two types of design considerations for clock optimization when interfacing the transceiver datapath to the FPGA fabric:

- PCS with FIFO in phase compensation mode – share clock network for identical channels
- PCS with FIFO in registered mode or PMA direct mode – refer to *AN 580: Achieving Timing Closure in Basic (PMA Direct) Functional Mode*, for additional timing closure techniques between transceiver and FPGA fabric

The following sections describe design considerations for interfacing the PCS transmitter and PCS receiver datapath to the FPGA fabric with FIFO in phase compensation mode.

Related Information**AN 580: Achieving Timing Closure in Basic (PMA Direct) Functional Mode**

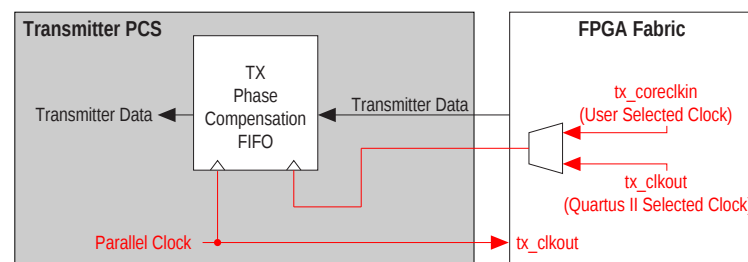
Transmitter Datapath Interface Clocking

The write side of the TX phase compensation FIFO makes up the transmitter datapath interface. The transmitter datapath interface clock clocks this interface.

The following figure shows the transmitter datapath interface clocking. The transmitter PCS forwards the following clocks to the FPGA fabric:

- tx_clkout—for each transmitter channel in a non-bonded configuration
- tx_clkout[0]—for all transmitter channels in a bonded configuration

Figure 2-16: Transmitter Datapath Interface Clocking for Transceivers



All configurations that use the PCS channel must have a 0 parts per million (ppm) difference between write and read clocks of the transmitter phase compensation FIFO.

Note: For more information about interface clocking for each configuration, refer to the *Transceiver Custom Configuration in Cyclone V Devices* and *Transceiver Protocol Configurations in Cyclone V Devices* chapters.

You can clock the transmitter datapath interface with one of the following options:

- The Quartus II-selected transmitter datapath interface clock
- The user-selected transmitter datapath interface clock

Note: To reduce GCLK, RCLK, and PCLK resource utilization in your design, you can select the user-selection option to share the transceiver datapath interface clocks.

Related Information

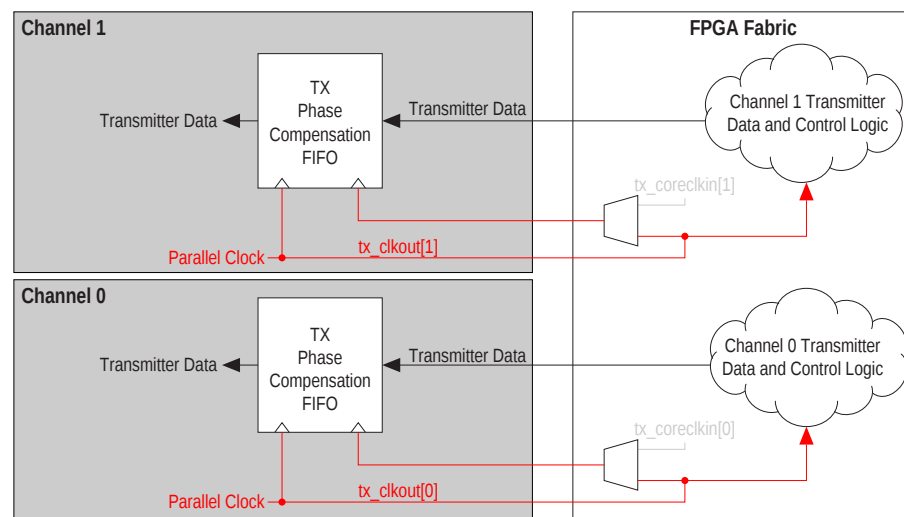
- [Transceiver Custom Configurations in Cyclone V Devices](#)
- [Transceiver Protocol Configurations in Cyclone V Devices](#)

Quartus II-Software Selected Transmitter Datapath Interface Clock

The Quartus II software automatically selects the appropriate clock from the FPGA fabric to clock the transmitter datapath interface.

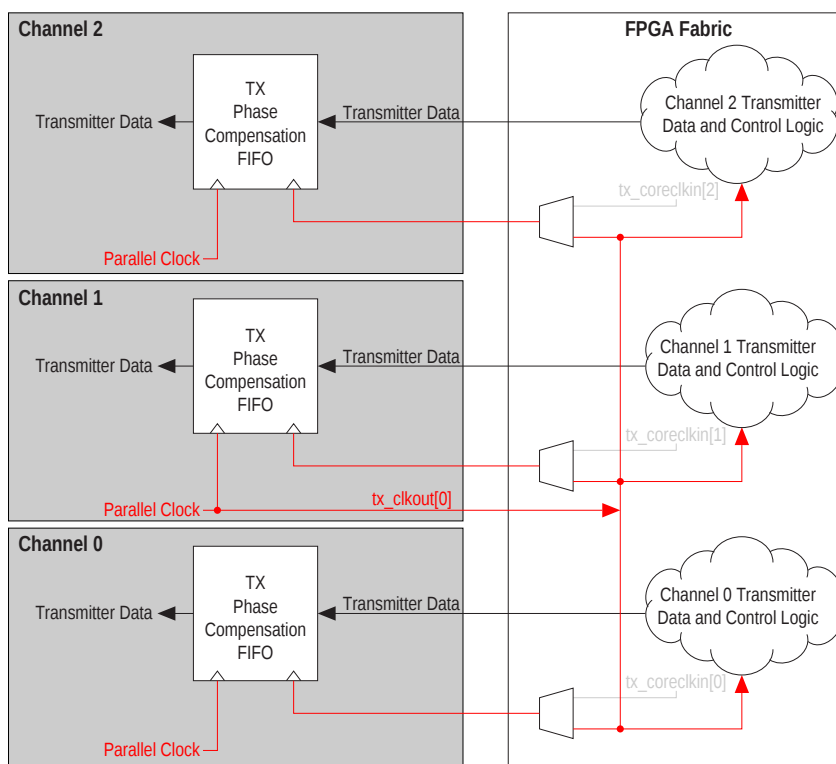
The following figure shows the transmitter datapath interface of two transceiver non-bonded channels clocked by their respective transmitter PCS clocks, which are forwarded to the FPGA fabric.

Figure 2-17: Transmitter Datapath Interface Clocking for Non-Bonded Channels



The following figure shows the transmitter datapath interface of three bonded channels clocked by the `tx_clkout[0]` clock. The `tx_clkout[0]` clock is derived from the central clock divider of channel 1 or 4 of the two transceiver banks.

Figure 2-18: Transmitter Datapath Interface Clocking for Three Bonded Channels



Selecting a Transmitter Datapath Interface Clock

Multiple non-bonded transmitter channels use a large portion of GCLK, RCLK, and PCLK resources. Selecting a common clock driver for the transmitter datapath interface of all identical transmitter channels saves clock resources.

Multiple transmitter channels that are non-bonded lead to high utilization of GCLK, RCLK, and PCLK resources (one clock resource per channel). You can significantly reduce GCLK, RCLK, and PCLK resource use for transmitter datapath clocks if the transmitter channels are identical.

Note: Identical transmitter channels have the same input reference clock source, transmit PLL configuration, transmitter PMA, and PCS configuration, but may have different analog settings, such as transmitter voltage output differential (V_{OD}), transmitter common-mode voltage (V_{CM}), or pre-emphasis settings.

To achieve the clock resource savings, select a common clock driver for the transmitter datapath interface of all identical transmitter channels. The following figure shows six identical channels clocked by a single clock (tx_clkout of channel 4).

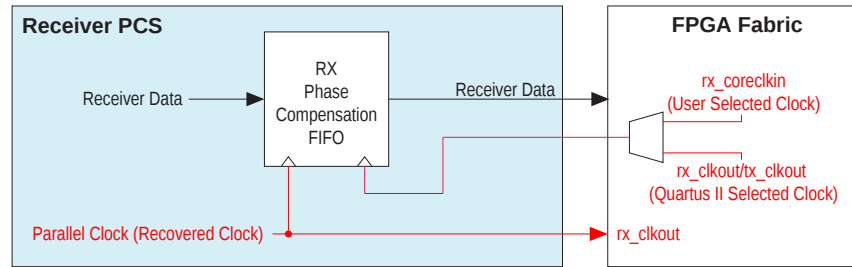
Receiver Datapath Interface Clock

The read side of the RX phase compensation FIFO makes up the 6-Gbps receiver datapath interface. The receiver datapath interface clock clocks this interface.

The receiver PCS forwards the following clocks to the FPGA fabric:

- `rx_clkout`—for each receiver channel in a non-bonded configuration when you do not use a rate matcher
- `tx_clkout`—for each receiver channel in a non-bonded configuration when you use a rate matcher
- single `rx_clkout[0]`—for all receiver channels in a bonded configuration

Figure 2-20: Receiver Datapath Interface Clocking



All configurations that use the PCS channel must have a 0 ppm difference between the receiver datapath interface clock and the read side clock of the RX phase compensation FIFO.

Note: For more information about interface clocking for each configuration, refer to the *Transceiver Custom Configuration in Cyclone V Devices* and *Transceiver Protocol Configurations in Cyclone V Devices* chapters.

You can clock the receiver datapath interface with one of the following options:

- The Quartus II-selected receiver datapath interface clock
- The user-selected receiver datapath interface clock

Note: To reduce GCLK, RCLK, and PCLK resource utilization in your design, you can select the user-selection option to share the transceiver datapath interface clocks.

Related Information

[Transceiver Custom Configuration in Cyclone V Devices](#)

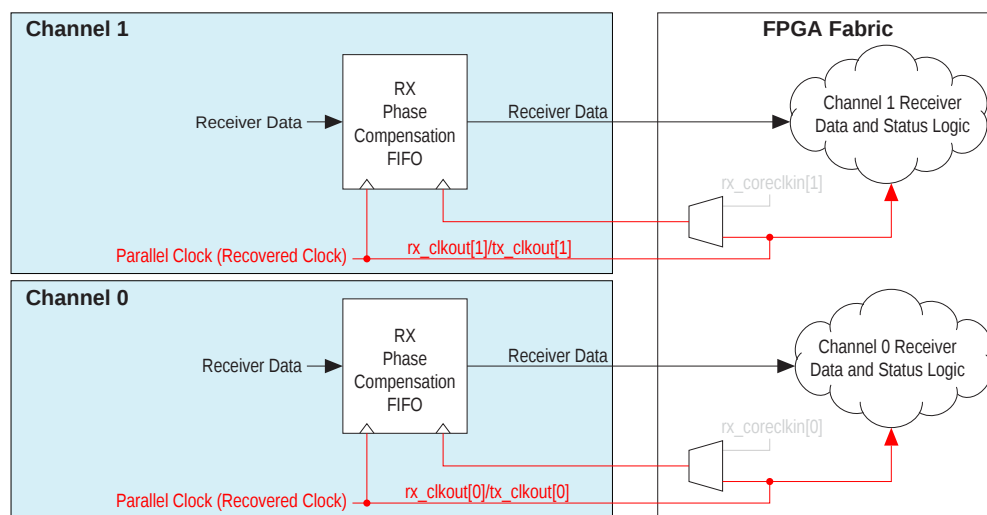
[Transceiver Protocol Configurations in Cyclone V Devices](#)

Quartus II Software-Selected Receiver Datapath Interface Clock

Quartus II automatically selects the appropriate clock from the FPGA fabric to clock the receiver datapath interface.

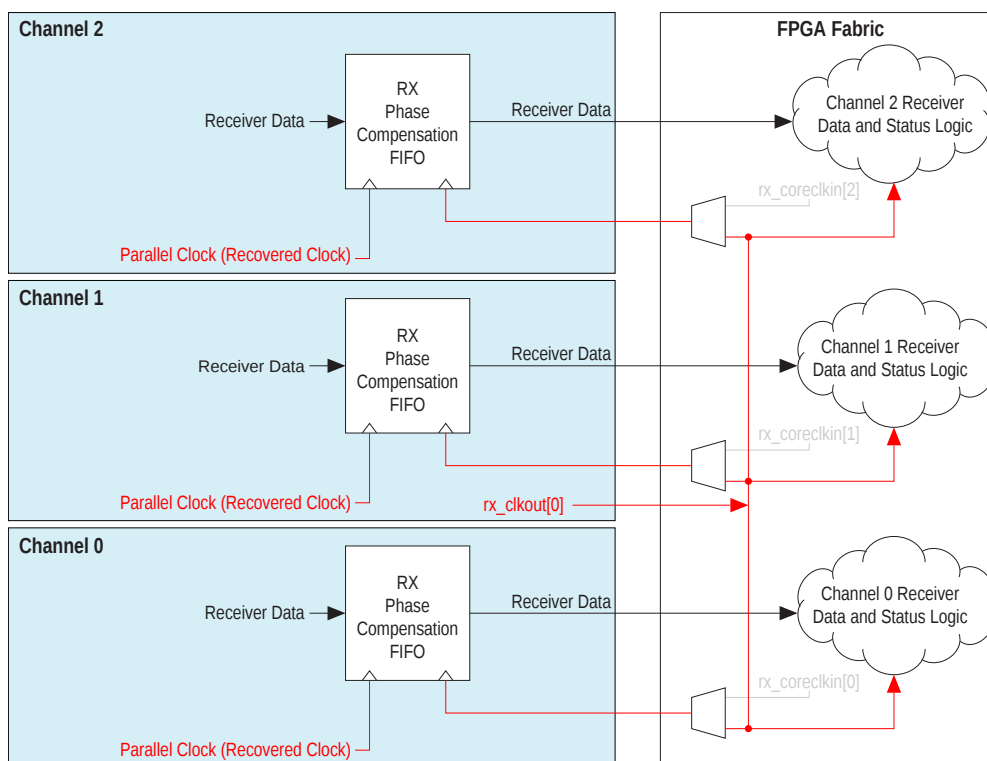
The following figure shows the receiver datapath interface of two transceiver non-bonded channels clocked by their respective receiver PCS clocks, which are forwarded to the FPGA fabric.

Figure 2-21: Receiver Datapath Interface Clocking for Non-Bonded Channels



The following figure shows the receiver datapath interface of three bonded channels clocked by the `tx_clkout[0]` clock. The `tx_clkout[0]` clock is derived from the central clock divider of channel 1 or 4 of the two transceiver banks.

Figure 2-22: Receiver Datapath Interface Clocking for Three Bonded Channels



Selecting a Receiver Datapath Interface Clock

Multiple non-bonded receiver channels use a large portion of GCLK, RCLK, and PCLK resources. Selecting a common clock driver for the receiver datapath interface of all identical receiver channels saves clock resources.

Non-bonded multiple receiver channels lead to high utilization of GCLK, RCLK, and PCLK resources (one clock resource per channel). You can significantly reduce GCLK, RCLK, and PCLK resource use for the receiver datapath clocks if the receiver channels are identical.

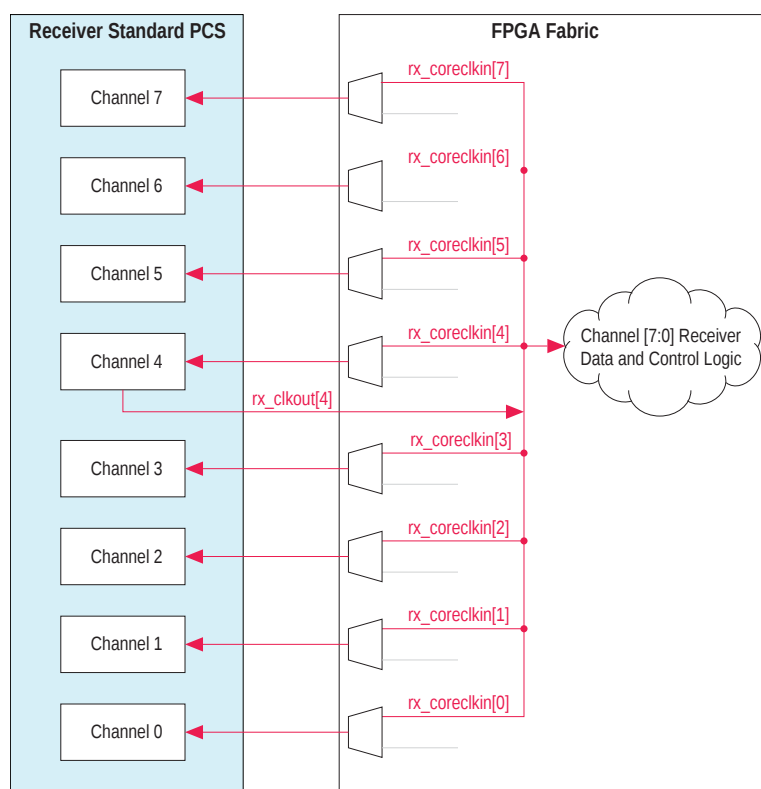
Note: Identical receiver channels are defined as channels that have the same input reference clock source for the CDR and the same receiver PMA and PCS configuration. These channels may have different analog settings, such as receiver common mode voltage (V_{ICM}), equalization, or DC gain setting.

To achieve clock resource savings, select a common clock driver for the receiver datapath interface of all identical receiver channels. To select a common clock driver, perform these steps:

1. Instantiate the `rx_coreclkln` port for all the identical receiver channels
2. Connect the common clock driver to their receiver datapath interface, and receiver data and control logic.

The following figure shows six identical channels that are clocked by a single clock (`rx_clkout[0]`).

Figure 2-23: Six Identical Channels with a Single User-Selected Receiver Interface Clock



To clock six identical channels with a single clock, perform these steps:

- Instantiate the `rx_coreclk_in` port for all the identical receiver channels (`rx_coreclk_in[5:0]`).
- Connect `rx_clkout[4]` to the `rx_coreclk_in[5:0]` ports.
- Connect `rx_clkout[4]` to the receiver data and control logic for all six channels.

Note: Resetting or powering down channel 4 leads to a loss of the clock for all six channels.

The common clock must have a 0 ppm difference for the write side of the RX phase compensation FIFO of all the identical channels. A frequency difference causes the FIFO to under run or overflow, depending on whether the common clock is faster or slower, respectively.

You can drive the 0 ppm common clock driver from one of the following sources:

- `tx_clkout` of any channel in non-bonded receiver channel configurations with the rate matcher
- `rx_clkout` of any channel in non-bonded receiver channel configurations without the rate matcher
- `tx_clkout[0]` in bonded receiver channel configurations
- Dedicated `refclk` pins

Note: The Quartus II software does not allow gated clocks or clocks generated in the FPGA logic to drive the `rx_coreclk_in` ports.

Note: You must ensure a 0 ppm difference. The Quartus II software is unable to ensure a 0 ppm difference because it allows you to use external pins, such as dedicated `refclk` pins.

Document Revision History

The table below lists the revision history for this chapter.

Table 2-10: Document Revision History

Date	Version	Changes
May 2013	2013.05.06	<ul style="list-style-type: none"> • Updated Content for Quartus II software version 13.0 • Updated figure "Input Reference Clock Sources for Transceiver Channels" • Added a section on "Dual-Purpose RX/refclk Pins". • Added link to the known document issues in the Knowledge Base.
November 2012	2012.11.19	<ul style="list-style-type: none"> • Reorganized content and updated template. • Updated for the Quartus II software version 12.1.
June 2012	1.1	Minor editorial changes.
October 2011	1.0	Initial release.

2013.05.06

CV-53003



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Altera's recommended reset sequence ensures that both the physical coding sublayer (PCS) and physical medium attachment (PMA) in each transceiver channel are initialized and functioning correctly.

Related Information

[Cyclone V Device Handbook: Known Issues](#)

Lists the planned updates to the *Cyclone V Device Handbook* chapters.

PHY IP Embedded Reset Controller

The embedded reset controller in the PHY IP enables you to initialize the transceiver physical coding sublayer (PCS) and physical medium attachment (PMA) blocks.

To simplify your transceiver-based design, the embedded reset controller provides an option that requires only one control input to implement an automatic reset sequence. Only one embedded reset controller is available for all the channels in a PHY IP instance.

The embedded reset controller automatically performs the entire transceiver reset sequence whenever the `phy_mgmt_clk_reset` signal is triggered. In case of loss-of-link or loss-of-data, the embedded reset controller asserts the appropriate reset signals. You must monitor `tx_ready` and `rx_ready`. A high on these status signals indicates the transceiver is out of reset and ready for data transmission and reception.

Note: Deassert the `mgmt_rst_reset` signal of the transceiver reconfiguration controller before or at the same time as `phy_mgmt_clk_reset` to start calibration.

Note: The PHY IP embedded reset controller is enabled by default in all transceiver PHY IP cores except the Native PHY IP core.

Embedded Reset Controller Signals

The following figure shows the embedded reset controller and signals in the PHY IP instance. These signals reset your transceiver when you use the embedded reset controller.

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Figure 3-1: Embedded Reset Controller

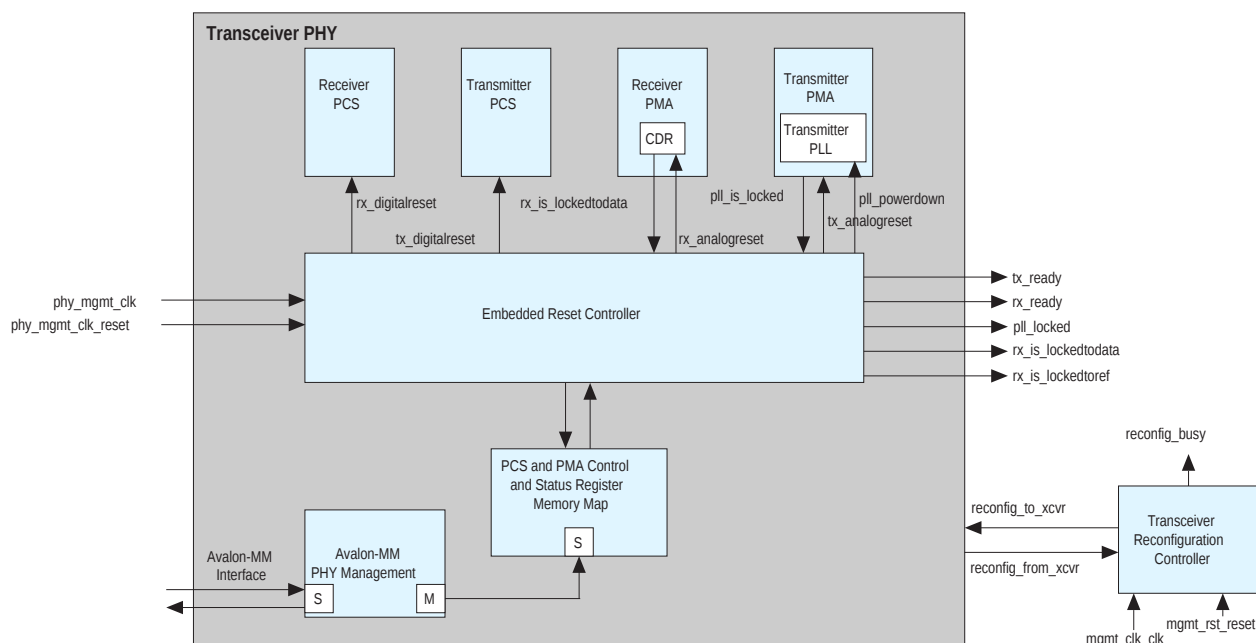


Table 3-1: Embedded Reset Controller Reset Control and Status Signals

Signal Name	Signal	Description
phy_mgmt_clk	Control Input	Clock for the embedded reset controller.
phy_mgmt_clk_reset	Control Input	A high-to-low transition of this asynchronous reset signal initiates the automatic reset sequence control. Hold this signal high to keep the reset signals asserted.
tx_ready	Status Output	A continuous high on this signal indicates that the transmitter (TX) channel is out of reset and is ready for data transmission. This signal is synchronous to phy_mgmt_clk.
rx_ready	Status Output	A continuous high on this signal indicates that the receiver (RX) channel is out of reset and is ready for data reception. This signal is synchronous to phy_mgmt_clk.

Signal Name	Signal	Description
reconfig_busy	Status Output	<p>An output from the Transceiver Reconfiguration Controller block indicates the status of the dynamic reconfiguration controller. At the first <code>mgmt_clk_clk</code> clock cycle after power-up, <code>reconfig_busy</code> remains low.</p> <p>This signal is asserted from the second <code>mgmt_clk_clk</code> clock cycle to indicate that the calibration process is in progress. When the calibration process is completed, the <code>reconfig_busy</code> signal is deasserted.</p> <p>This signal is also routed to the embedded reset controller by the Quartus® II software by embedding the signal in the <code>reconfig_to_xcvr</code> bus between the PHY IP and the Transceiver Reconfiguration Controller.</p>
pll_locked	Status Output	<p>This signal is asserted when the TX PLL achieves lock to the input reference clock. When this signal is asserted high, the embedded reset controller deasserts the <code>tx_digitalreset</code> signal.</p>
rx_is_lockedtodata	Status Output	<p>This signal is an optional output status port. When asserted, this signal indicates that the CDR is locked to the RX data and the CDR has changed from lock-to-reference (LTR) to lock-to-data (LTD) mode.</p>
rx_is_lockedtoref	Status Output	<p>This is an optional output status port. When asserted, this signal indicates that the CDR is locked to the reference clock.</p>
mgmt_clk_clk	Clock	<p>Clock for the Transceiver Reconfiguration Controller. This clock must be stable before releasing <code>mgmt_rst_reset</code>.</p>
mgmt_rst_reset	Reset	<p>Reset for the Transceiver Reconfiguration Controller</p>

Resetting the Transceiver with the PHY IP Embedded Reset Controller during Device Power-Up

Follow this reset sequence to ensure a reliable link initialization after the initial power-up.

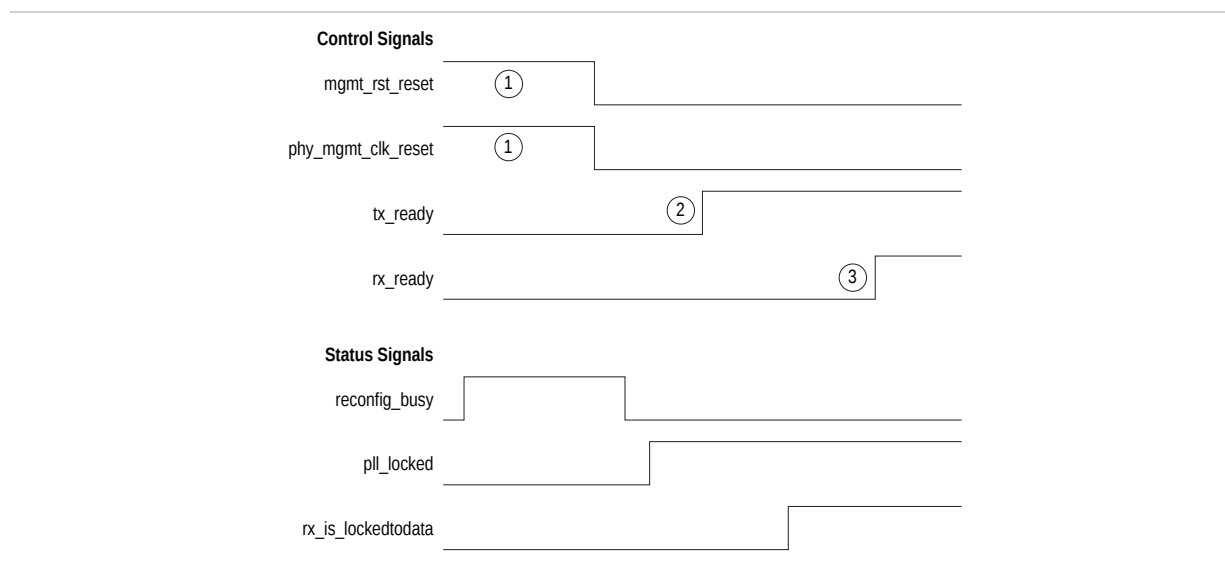
The numbers in the following figure correspond to the following numbered list, which guides you through the transceiver reset sequence during device power-up.

1. During device power-up, `mgmt_rst_reset` and `phy_mgmt_clk_reset` must be asserted to initialize the reset sequence. `phy_mgmt_clk_reset` holds the transceiver blocks in reset and `mgmt_rst_reset` is required to start the calibration IPs. Both these signals should be held asserted for a minimum of two `phy_mgmt_clk` clock cycles. Deassert `phy_mgmt_clk_reset` at the same time as `mgmt_rst_reset`.
2. After the transmitter calibration and reset sequence are complete, the `tx_ready` status signal is asserted and remains asserted to indicate that the transmitter is ready to transmit data.

- After the receiver calibration and reset sequence are complete, the `rx_ready` status signal is asserted and remains asserted to indicate that the receiver is ready to receive data.

Note: If the `tx_ready` and `rx_ready` signals do not stay asserted, the reset sequence did not complete successfully and the link will be down.

Figure 3-2: Reset Sequence Timing Diagram Using Embedded Reset Controller during Device Power-Up



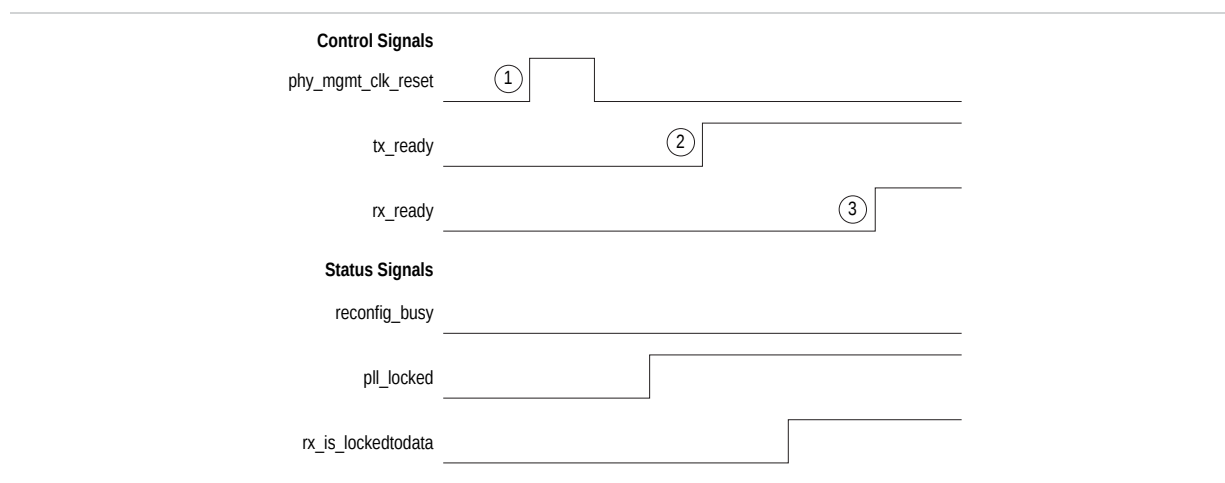
Resetting the Transceiver with the PHY IP Embedded Reset Controller during Device Operation

Follow this reset sequence to reset the entire transceiver at any point during the device operation, to re-establishing a link, or after certain dynamic reconfigurations.

The numbers in the following figure correspond to the numbered list, which guides you through the transceiver reset sequence during device operation.

- Assert `phy_mgmt_clk_reset` for two `phy_mgmt_clk` clock cycles to re-start the entire transceiver reset sequence.
- After the transmitter reset sequence is complete, the `tx_ready` status signal is asserted and remains asserted to indicate that the transmitter is ready to transmit data.
- After the receiver reset sequence is complete, the `rx_ready` status signal is asserted and remains asserted to indicate that the receiver is ready to receive data.

Note: If the `tx_ready` and `rx_ready` signals do not stay asserted, the reset sequence did not complete successfully and the link will be down.

Figure 3-3: Reset Sequence Timing Diagram Using Embedded Reset Controller during Device Operation

Note: To reset the transmitter and receiver analog and digital blocks separately without repeating the entire reset sequence, use the Avalon Memory Map registers.

User-Coded Reset Controller

You must implement external reset controller logic (user-coded reset controller) if you disable the embedded reset controller to initialize the transceiver physical coding sublayer (PCS) and physical medium attachment (PMA) blocks.

You can implement a user-coded reset controller with one of the following:

- Using your own Verilog/VHDL code to implement the reset sequence
- Using the Quartus II MegaWizard Plug-In Manager, which provides a ready-made reset controller IP to place your own verilog/vhdl code

Note: You must disable the embedded reset controller before using the user-coded reset controller.

Note: The embedded reset controller can only be disabled for non-protocol transceiver PHY IPs, such as custom PHY, low latency PHY and deterministic latency PHY. Native PHY IP does not have an embedded reset controller, so you must implement your own reset logic.

If you implement your own reset controller, consider the following:

- The user-coded reset controller must be level sensitive (active high)
- The user-coded reset controller does not depend on `phy_mgmt_clk_reset`
- You must provide a clock and reset to the reset controller logic
- The internal signals of the PHY IP embedded reset controller are configured as ports
- You can hold the transceiver channels in reset by asserting the appropriate reset control signals

Related Information

"*Transceiver PHY Reset Controller IP Core*" chapter of the *Altera Transceiver PHY IP Core User Guide*.
For information about the transceiver PHY reset controller.

User-Coded Reset Controller Signals

Use the signals in the following figure and table with a user-coded reset controller.

Figure 3-4: Interaction Between the Transceiver PHY Instance, Transceiver Reconfiguration Controller, and the User-Coded Reset Controller

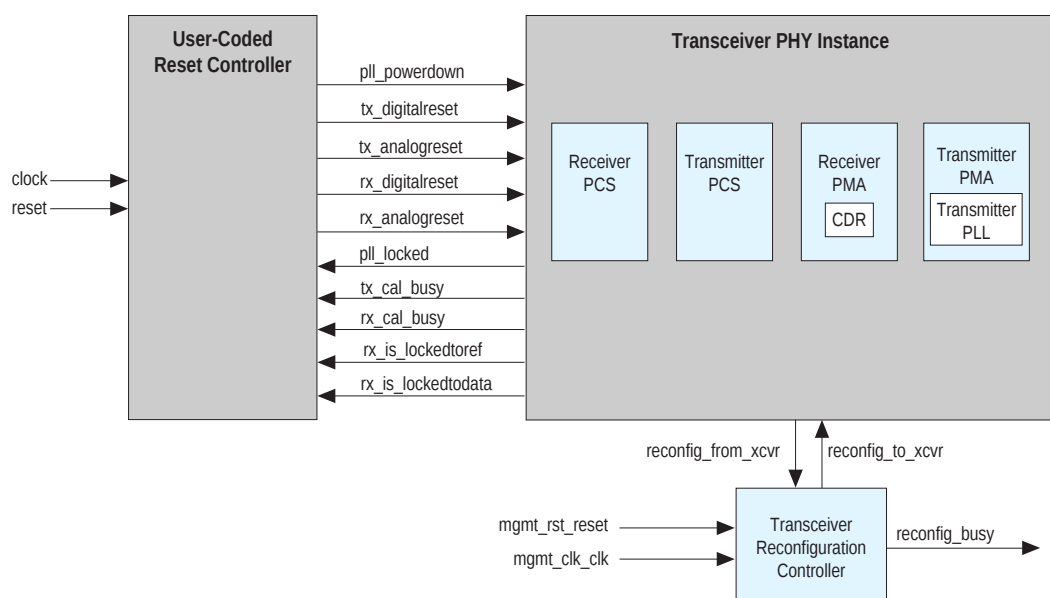


Table 3-2: Signals Used by the Transceiver PHY instance, Transceiver Reconfiguration Controller, and User-Coded Reset Controller

Signal Name	Signal Type	Description
mgmt_clk_clk	Clock	Clock for the Transceiver Reconfiguration Controller. This clock must be stable before releasing mgmt_rst_reset.
mgmt_rst_reset	Reset	Reset for the Transceiver Reconfiguration Controller
pll_powerdown	Control	Resets the TX PLL when asserted high
tx_analogreset	Control	Resets the TX PMA when asserted high
tx_digitalreset	Control	Resets the TX PCS when asserted high
rx_analogreset	Control	Resets the RX PMA when asserted high
rx_digitalreset	Control	Resets the RX PCS when asserted high
reconfig_busy	Status	A high on this signal indicates that reconfiguration is active
tx_cal_busy	Status	A high on this signal indicates that TX calibration is active

Signal Name	Signal Type	Description
rx_cal_busy	Status	A high on this signal indicates that RX calibration is active
pll_locked	Status	A high on this signal indicates that the TX PLL is locked
rx_is_lockedtoref	Status	A high on this signal indicates that the RX CDR is in the lock to reference (LTR) mode
rx_is_lockedtodata	Status	A high on this signal indicates that the RX CDR is in the lock to data (LTD) mode

Resetting the Transmitter with the User-Coded Reset Controller during Device Power-Up

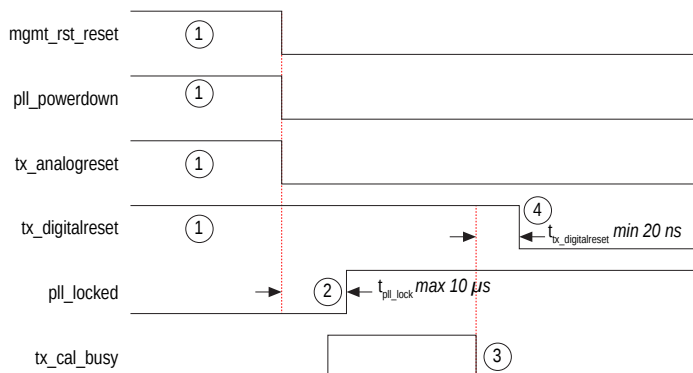
Follow this reset sequence when designing your User-Coder Reset Controller to ensure a reliable transmitter initialization after the initial power-up.

The numbers in the figure correspond to the following numbered list, which guides you through the transmitter reset sequence during device power-up.

1. To reset the transmitter, begin with:
 - Assert `mgmt_rst_reset` at power-up to start the calibration IPs. Hold `mgmt_rst_reset` active for a minimum of two reset controller clock cycles.
 - Assert and hold `pll_powerdown`, `tx_analogreset`, and `tx_digitalreset` at power-up to reset the transmitter. You can deassert `tx_analogreset` at the same time as `pll_powerdown`.
2. After the transmitter PLL locks, the `pll_locked` status gets asserted after $t_{\text{pll_lock}}$.
3. After the transmitter calibration completes, the `tx_cal_busy` status is deasserted. Depending on the transmitter calibrations, this could happen before or after the `pll_locked` is asserted.
4. Deassert `tx_digitalreset` after the gating conditions occur for a minimum duration of $t_{\text{tx_digitalreset}}$. The gating conditions are:
 - `pll_powerdown` is deasserted
 - `pll_locked` is asserted
 - `tx_cal_busy` is deasserted

The transmitter is out of reset and ready for operation.

Note: During calibration, `pll_locked` might assert and deassert as the calibration IP runs.

Figure 3-5: Reset Sequence Timing Diagram for Transmitter using the User-Coded Reset Controller during Device Power-Up**Table 3-3: Guidelines for Resetting the PLL, TX PMA, and TX PCS**

To Reset	You Must Reset
PLL	pll_powerdown tx_analogreset tx_digitalreset
TX PMA	tx_analogreset tx_digitalreset
TX PCS	tx_digitalreset

Resetting the Transmitter with the User-Coded Reset Controller during Device Operation

Follow this reset sequence if you want to reset the PLL, or analog or digital blocks of the transmitter at any point during device operation. This might be necessary for re-establishing a link or after certain dynamic reconfigurations.

The numbers in the following figure correspond to the following numbered list, which guides you through the transmitter reset sequence during device operation.

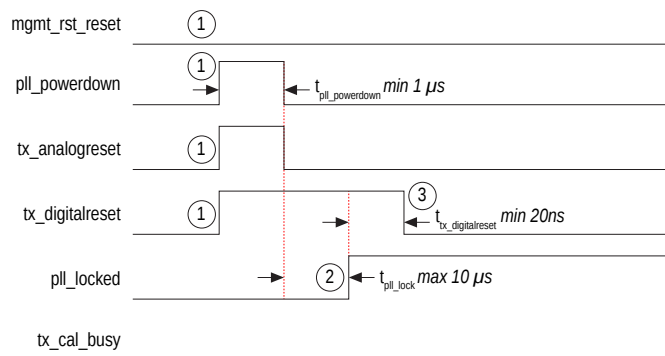
1. To reset the transmitter:

- Assert `pll_powerdown`, `tx_analogreset` and `tx_digitalreset`. `tx_digitalreset` must be asserted every time `pll_powerdown` and `tx_analogreset` are asserted to reset the PCS blocks.
- Hold `pll_powerdown` asserted for a minimum duration of $t_{pll_powerdown}$.
- Deassert `tx_analogreset` at the same time or after `pll_powerdown` is deasserted.

2. After the transmitter PLL locks, the `pll_locked` status is asserted after t_{pll_lock} . While the TX PLL locks, the `pll_locked` status signal may toggle. It is asserted after t_{pll_lock} .

3. Deassert `tx_digitalreset` after a minimum duration of $t_{tx_digitalreset}$ and after all the gating conditions are removed:
 - `pll_powerdown` is deasserted
 - `pll_locked` is deasserted

Figure 3-6: Reset Sequence Timing Diagram for Transmitter using the User-Coded Reset Controller during Device Operation



Resetting the Receiver with the User-Coded Reset Controller during Device Power-Up Configuration

Follow this reset sequence to ensure a reliable receiver initialization after the initial power-up.

The numbers in the following figure correspond to the following numbered list, which guides you through the receiver reset sequence during device power-up.

1. Assert `mgmt_rst_reset` at power-up to start the calibration IPs. Hold `mgmt_rst_reset` active for a minimum of two `mgmt_clk_clock` cycles. Hold `rx_analogreset` and `rx_digitalreset` active at power-up to hold the receiver in reset. You can deassert them after all the gating conditions are removed.
2. After the receiver calibration completes, the `rx_cal_busy` status is de-asserted.
3. Deassert `rx_analogreset` after a minimum duration of $t_{rx_analogreset}$ after `rx_cal_busy` is deasserted.
4. `rx_is_lockedtodata` is a status signal from the receiver CDR indicating that the CDR is in the lock to data (LTD) mode. Ensure `rx_is_lockedtodata` is asserted and stays asserted for a minimum duration of t_{LTD} before deasserting `rx_digitalreset`. If `rx_is_lockedtodata` is asserted and toggles, you must wait another additional t_{LTD} duration before deasserting `rx_digitalreset`.
5. Deassert `rx_digitalreset` after a minimum duration of t_{LTD} after `rx_is_lockedtodata` stays asserted. Ensure `rx_analogreset` and `rx_cal_busy` are deasserted before deasserting `rx_digitalreset`.

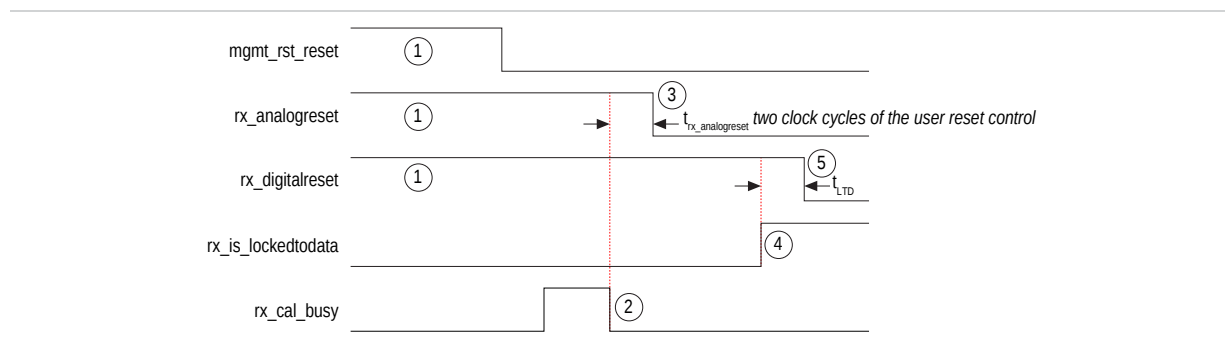
The receiver is now out of reset and ready for operation.

Note: `rx_is_lockedtodata` might toggle when there is no data at the receiver input.

Note: `rx_is_lockedtoref` is a don't care when `rx_is_lockedtodata` is asserted.

Note: `rx_analogreset` must always be followed by `rx_digitalreset`.

Figure 3-7: Reset Sequence Timing Diagram for Receiver using the User-Coded Reset Controller during Device Power-Up



Related Information

Transceiver Architecture in Cyclone V Devices

For information about CDR lock modes.

Resetting the Receiver with the User-Coded Reset Controller during Device Operation

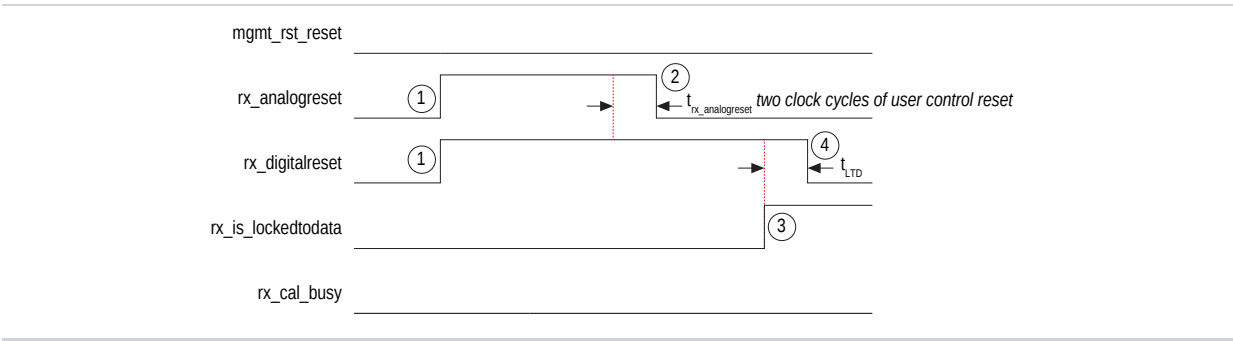
Follow this reset sequence to reset the analog or digital blocks of the receiver at any point during the device operation. This might be necessary for re-establishing a link or after certain dynamic reconfigurations.

The numbers in the following figure correspond to the following numbered list, which guides you through the receiver reset sequence during device operation.

1. Assert `rx_analogreset` and `rx_digitalreset` at any point independently. However, you must assert `rx_digitalreset` every time `rx_analogreset` is asserted to reset the PCS blocks.
2. Deassert `rx_analogreset` after a minimum duration of 40 ns ($t_{rx_analogreset}$).
3. `rx_is_lockedtodata` is a status signal from the receiver CDR that indicates that the CDR is in the lock to data (LTD) mode. Ensure `rx_is_lockedtodata` is asserted and stays asserted before deasserting `rx_digitalreset`.
4. Deassert `rx_digitalreset` after a minimum duration of t_{LTD} after `rx_is_lockedtodata` stays asserted. Ensure `rx_analogreset` is de-asserted.

Note: `rx_is_lockedtodata` might toggle when there is no data at the receiver input. `rx_is_lockedtoref` is a don't care when `rx_is_lockedtodata` is asserted.

Figure 3-8: Reset Sequence Timing Diagram for Receiver using the User-Coded Reset Controller during Device Operation



Related Information
[Transceiver Architecture in Cyclone V Devices](#)
For information about CDR lock modes.

Transceiver Reset Using Avalon Memory Map Registers

You can use Memory Map registers within the PHY IP instance to control the reset signals through the Avalon Memory Map interface.

This gives the flexibility of resetting the PLL, and transmitter and receiver analog and digital blocks separately without repeating the entire reset sequence.

Transceiver Reset Control Signals Using Avalon Memory Map Registers

The following table lists the memory map registers for CDR lock mode and channel reset. These signals help you reset your transceiver when you use Memory Map registers within the PHY IP.

Table 3-4: Transceiver Reset Control Using Memory Map Registers

Register Name	Description
<code>pma_rx_set_locktodata</code>	This register is for CDR manual lock mode only. When you set the register to high, the RX CDR PLL is in the lock to data (LTD) mode. The default is low when both registers have the CDR in auto lock mode.
<code>pma_rx_set_locktoref</code>	This register is for CDR manual lock mode only. When you set the register to high, the RX CDR PLL is in the lock to reference (LTR) mode if <code>pma_rx_set_lockedtodata</code> is not asserted. The default is low when both registers have the CDR in auto lock mode.

Register Name	Description
reset_tx_digital	When you set this register to high, the tx_digitalreset signal is asserted in every channel that is enabled for reset control through the reset_ch_bitmask register. To deassert the tx_digitalreset signal, set the reset_tx_digital register to 0.
reset_rx_analog	When you set this register to high, the rx_analogreset signal is asserted in every channel that is enabled for reset control through the reset_ch_bitmask register. To deassert the rx_analogreset signal, set the reset_rx_analog register to 0.
reset_rx_digital	When you set this register to high, the rx_digitalreset signal is asserted in every channel that is enabled for reset control through the reset_ch_bitmask register. To deassert the rx_digitalreset signal, set the reset_rx_digital register to 0.
reset_ch_bitmask	The registers provide an option to enable or disable certain channels in a PHY IP instance for reset control. By default, all channels in a PHY IP instance are enabled for reset control.
pll_powerdown	When asserted, the TX phase-locked loop (PLL) is turned off.

Related Information

[Altera Transceiver PHY IP Core User Guide](#)

For information about register addresses.

Clock Data Recovery Manual Lock Mode Reset Sequence

Use the clock data recovery (CDR) manual lock mode to override the default CDR automatic lock mode.

The two control signals to enable and control the CDR in manual lock mode are rx_set_locktoref and rx_set_locktodata.

Control Settings for CDR Manual Lock Mode

Use the following control signals to reset the transceiver when the CDR is in manual lock mode.

Table 3-5: Control Settings for the CDR in Manual Lock Mode

rx_set_locktoref	rx_set_locktodata	CDR Lock Mode
0	0	Automatic
1	0	Manual-RX CDR LTR
X	1	Manual-RX CDR LTD

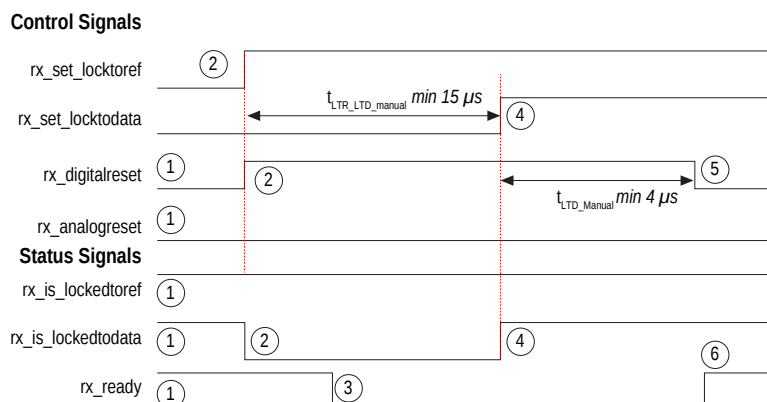
Resetting the Transceiver in CDR Manual Lock Mode

Follow this sequence to reset your transceiver when the CDR is in manual lock mode.

The numbers in the following figure correspond to the following numbered list, which guides you through the steps to put the CDR in manual lock mode.

1. Make sure that the calibration is complete (`rx_cal_busy` is low) and the transceiver goes through the initial reset sequence. The `rx_digitalreset` and `rx_analogreset` signals should be low. The `rx_is_lockedtoref` is a don't care and can be either high or low. The `rx_is_lockedtodata` and `rx_ready` signals should be high, indicating that the transceiver is out of reset. Alternatively, you can start directly with the CDR in manual lock mode after the calibration is complete.
2. Assert the `rx_set_locktoref` signal high to switch the CDR to the lock-to-reference mode. The `rx_is_lockedtodata` status signal gets de-asserted. Assert the `rx_digitalreset` signal high at the same time or after `rx_set_locktoref` is asserted if you use the user-controlled reset. When the Transceiver PHY reset controller is used, the `rx_digitalreset` is automatically asserted.
3. After the `rx_digitalreset` signal gets asserted, the `rx_ready` status signal gets de-asserted.
4. Assert the `rx_set_locktodata` signal high after t_{LTD_manual} to switch the CDR to the lock-to-data mode. The `rx_is_lockedtodata` status signal gets asserted when it acquires lock to the data. The `rx_is_lockedtoref` status signal can be a high or low and can be ignored.
5. Deassert the `rx_digitalreset` signal after t_{LTD_Manual} .
6. After the `rx_digitalreset` signal is de-asserted, the `rx_ready` status signal gets asserted if you are using the Transceiver PHY Reset Controller, indicating that the receiver is now ready to receive data with the CDR in manual mode.

Figure 3-9: Reset Sequence Timing Diagram for Transceiver when CDR is in Manual Lock Mode



Resetting the Transceiver During Dynamic Reconfiguration

Reset is required for transceiver during dynamic reconfiguration except in the PMA Analog Control Reconfiguration mode.

In general, follow these guidelines when dynamically reconfiguring the transceiver:

1. Hold the targeted channel and PLL in the reset state before dynamic reconfiguration starts.

- Repeat the sequence as needed after dynamic reconfiguration is complete, which is indicated by deassertion of the `reconfig_busy`, `tx_cal_busy`, `rx_cal_busy` signals.

Guidelines for Dynamic Reconfiguration if Transmitter Duty Cycle Distortion Calibration is Required during Device Operation

If transmitter duty cycle distortion calibration is required during device operation, ensure the general guidelines for transceiver dynamic reconfiguration are followed. Additionally, use the following recommendations:

- Do not connect `tx_cal_busy` to the transceiver Reset Controller IP.
- Disable the embedded reset controller and use an external reset controller.

Note: If channel reconfiguration is required before TX DCD calibration, ensure the following:

- The TX PLL, TX channel, and Transceiver Reconfiguration Controller blocks must not be in the reset state during TX DCD calibration. Ensure the following signals are not asserted during TX DCD calibration:
 - `pll_powerdown`
 - `tx_digitalreset`
 - `tx_analogreset`
 - `mgmt_rst_reset`

Repeat the reset sequence when TX DCD calibration is complete.

Transceiver Blocks Affected by the Reset and Powerdown Signals

The following table lists blocks that are affected by specific reset and powerdown signals

Table 3-6: Transceiver Blocks Affected

Transceiver Block	pll_powerdown	rx_digital-reset	rx_analogreset	tx_digitalreset	tx_analogreset
PLL					
CMU PLL	Yes	—	—	—	—
Receiver Standard PCS					
Receiver Word Aligner	—	Yes	—	—	—
Receiver Deskew FIFO	—	Yes	—	—	—
Receiver Rate Match FIFO	—	Yes	—	—	—
Receiver 8B/10B Decoder	—	Yes	—	—	—
Receiver Byte Deserializer	—	Yes	—	—	—
Receiver Byte Ordering	—	Yes	—	—	—

Transceiver Block	pll_powerdown	rx_digital-reset	rx_analogreset	tx_digitalreset	tx_analogreset
Receiver Phase Compensation FIFO	—	Yes	—	—	—
Receiver PMA					
Receiver Buffer	—	—	Yes	—	—
Receiver CDR	—	—	Yes	—	—
Receiver Deserializer	—	—	Yes	—	—
Transmitter Standard PCS					
Transmitter Phase Compensation FIFO	—	—	—	Yes	—
Byte Serializer	—	—	—	Yes	—
8B/10B Encoder	—	—	—	Yes	—
Transmitter Bit-Slip	—	—	—	Yes	—
Transmitter PMA					
Transmitter CGB	—	—	—	—	Yes
Serializer	—	—	—	—	Yes
Transmitter Buffer	—	—	—	—	Yes

Transceiver Power-Down

To maximize power savings, enable PMA hard power-down across all channels on a side of the device where you do not use the transceivers.

The hard power-down granularity control of the transceiver PMA is per side. To enable PMA hard power-down on the left or right side of the device, ground the transceiver power supply of the respective side.

Related Information

[Cyclone V Device Datasheet](#)

For information about the transceiver power supply operating conditions of the left and right side of Cyclone V devices.

Document Revision History

Date	Version	Changes
		<ul style="list-style-type: none"> Changed term of User-Controlled Reset Controller to User-Coded Reset Controller.

Date	Version	Changes
May 2013	2013.05.06	<ul style="list-style-type: none"> Updated the guidelines for Dynamic Reconfiguration if TX DCD Calibration is required during device operation. Added link to the known document issues in the Knowledge Base.
November 2012	2012.11.19	<ul style="list-style-type: none"> Rewritten and reorganized content, and updated template Updated reset sequence procedures Included sequences for resetting transceiver during device operation
November 2011	1.1	<ul style="list-style-type: none"> Added “User-Controlled Reset Controller” section. Updated Figure 3–1 and Table 3–1.
August 2011	1.0	Initial release.

Transceiver Protocol Configurations in Cyclone V Devices

4

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The dedicated transceiver physical coding sublayer (PCS) and physical medium attachment (PMA) circuitry supports the following communication protocols.

Table 4-1: Transceiver PCS Features for Cyclone V Devices

PCS Support	Data Rates (Gbps)	Transmitter Datapath	Receiver Datapath
PCI Express® (PCIe®) Gen1 (x1, x2, and x4) and Gen2 (x1, x2, and x4)	2.5, 5	PIPE (PHY Interface for the PCIe architecture) interface to the PCIe Hard IP	PIPE interface to the PCIe Hard IP
Gbps Ethernet (GbE)	1.25, 3.125	The same as custom single- and double-width modes	The same as custom single- and double-width modes, plus the rate match FIFO
Serial Digital Interface (SDI)	0.27 ⁽¹⁰⁾ , 1.485, and 2.97	Phase compensation FIFO and byte serializer	Phase compensation FIFO and byte deserializer
SATA, SAS	1.5 and 3.0	Phase compensation FIFO, byte serializer, and 8B/10B encoder	Phase compensation FIFO, byte deserializer, word aligner, and 8B/10B decoder
Common Public Radio Interface (CPRI)	0.6144, 1.2288, 2.4576, 3.072, 4.9152, 6.144 ⁽¹¹⁾	The same as custom single- and double-width modes, plus the transmitter (TX) deterministic latency	The same as custom single- and double-width modes, plus the receiver (RX) deterministic latency

⁽¹⁰⁾ The 0.27 gigabits per second (Gbps) data rate is supported using oversampling user logic that must be implemented by the user in the FPGA core.

⁽¹¹⁾ Cyclone V GT devices support data rates greater than 5.0 Gbps only in CPRI.

PCS Support	Data Rates (Gbps)	Transmitter Datapath	Receiver Datapath
OBSAI	0.768, 1.536, 3.072	The same as custom single- and double-width modes, plus the TX deterministic latency	The same as custom single- and double-width modes, plus the RX deterministic latency
XAUI	3.125	Implemented using soft PCS	Implemented using soft PCS

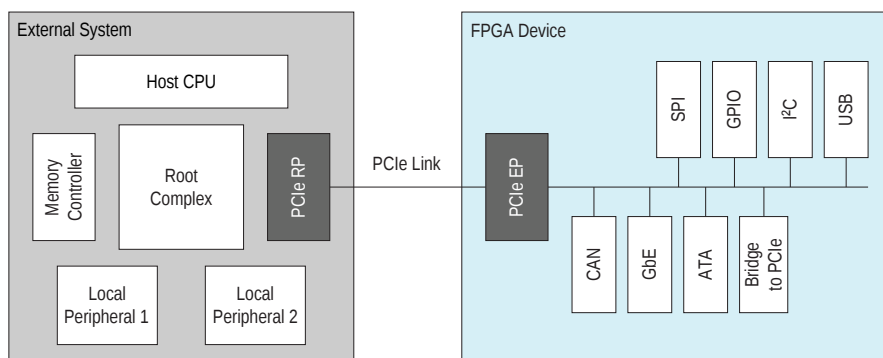
Related Information

- [Use this chapter along with the Altera Transceiver PHY IP Core User Guide.](#)
- [Upcoming Cyclone V Device Features](#)
- [Cyclone V Device Handbook: Known Issues](#)
Lists the planned updates to the *Cyclone V Device Handbook* chapters.

PCI Express

The Cyclone V devices have PCIe Hard IP that is designed for performance, ease-of-use, and increased functionality. The Hard IP consists of the media access control (MAC) lane, data link, and transaction layers. The PCIe Hard IP supports the PCIe Gen1 end point and root port up to x4 lane configurations. The PCIe endpoint support includes multifunction support for up to eight functions and Gen2 x4 lane configurations.

Figure 4-1: PCIe Multifunction for Cyclone V Devices

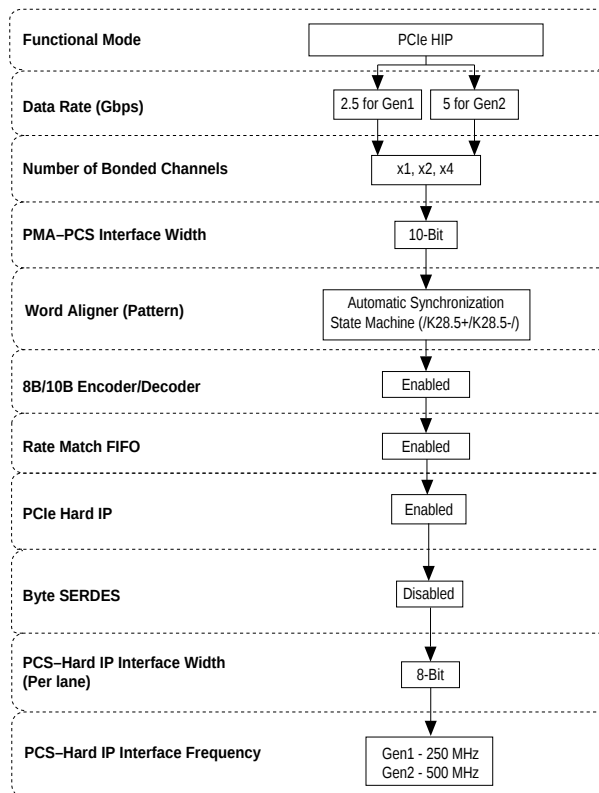


The Cyclone V PCIe Hard IP operates independently from the core logic, which allows the PCIe link to wake up and complete link training in less than 100 ms while the Cyclone V device completes loading the programming file for the rest of the device.

In addition, the Cyclone V device PCIe Hard IP has improved end-to-end datapath protection using error correction code (ECC).

PIPE Transceiver Datapath

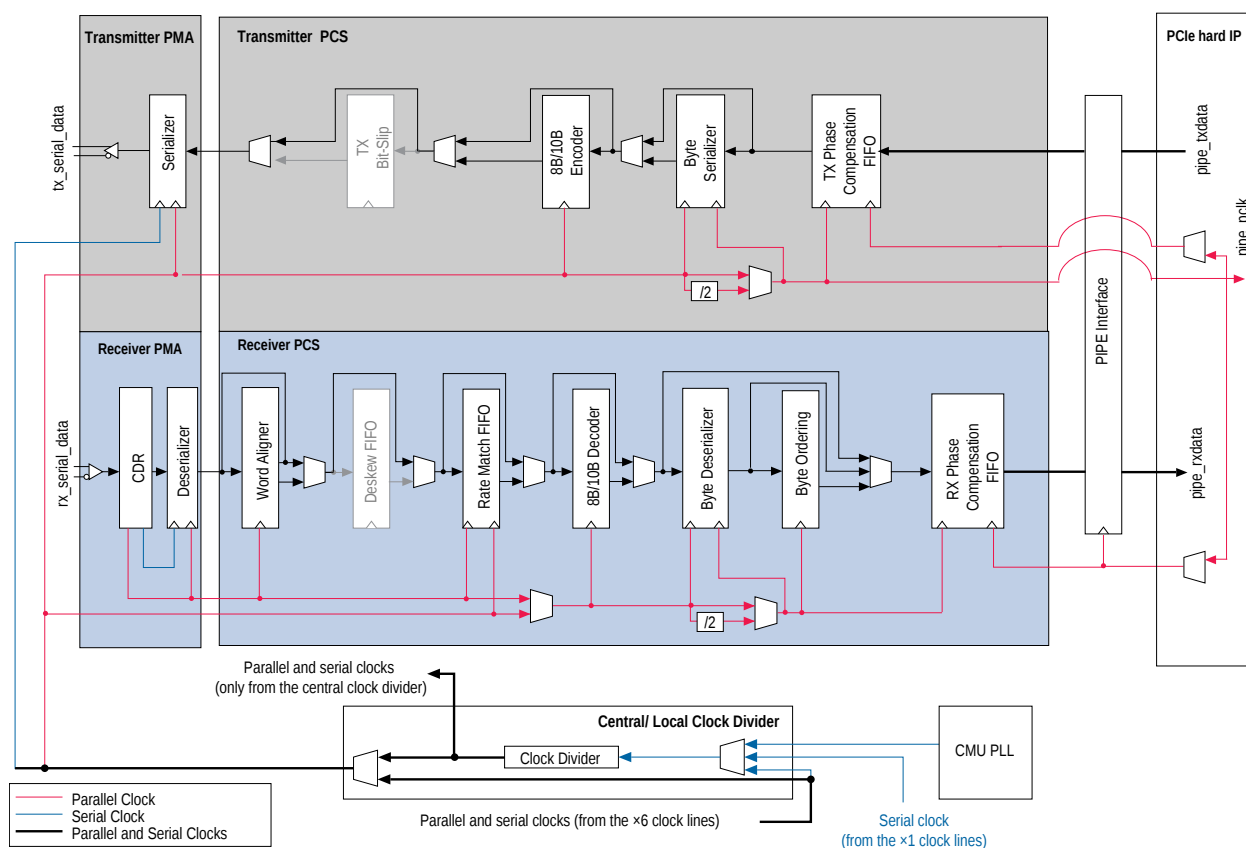
Figure 4-2: Transceivers in a PCIe Hard IP Configuration



Note: Refer to the *Cyclone V Device Datasheet* for the `mgmt_clk_clk` frequency specification when PCIe HIP is used.

Transceiver Channel Datapath

Figure 4-3: Transceiver Channel Datapath in a PIPE Configuration



Related Information

- [Transceiver Architecture in Cyclone V Devices](#)
- [Cyclone V Device Datasheet](#)

PCIe Supported Features

The PIPE configuration for the 2.5 Gbps (Gen1) and 5 Gbps (Gen2) data rates supports these features:

- PCIe-compliant synchronization state machine
- x1 and x4 link configurations
- ± 300 parts per million (ppm)—total 600 ppm—clock rate compensation
- 8-bit FPGA fabric-transceiver interface
- 16-bit FPGA fabric-transceiver interface
- Transmitter buffer electrical idle
- Receiver detection
- 8B/10B encoder disparity control when transmitting compliance pattern
- Power state management (Electrical Idle only)
- Receiver status encoding

PIPE Interface

In a PIPE configuration, each channel has a PIPE interface block that transfers data, control, and status signals between the PHY-MAC layer and the transceiver channel PCS and PMA blocks.

Note: The PIPE interface block is used in a PIPE configuration and cannot be bypassed.

In addition to transferring data, control, and status signals between the PHY-MAC layer and the transceiver, the PIPE interface block implements the following functions that are required in a PCIe-compliant physical layer device:

- Forces the transmitter buffer into an electrical idle state
- Initiates the receiver detect sequence
- Controls the 8B/10B encoder disparity when transmitting a compliance pattern
- Manages the PCIe power states (Electrical Idle only)
- Indicates the completion of various PHY functions, such as receiver detection and power state transitions on the `pipe_phystatus` signal
- Encodes the receiver status and error conditions on the `pipe_rxstatus[2:0]` signal, as specified in the PCIe specification

Transmitter Electrical Idle Generation

The PIPE interface block places the channel transmitter buffer in an electrical idle state when the electrical idle input signal is asserted.

During electrical idle, the transmitter buffer differential and common configuration output voltage levels are compliant to the PCIe Base Specification 2.1 for the PCIe Gen2 data rate.

The PCIe specification requires that the transmitter buffer be placed in electrical idle in certain power states.

Power State Management

The PCIe specification defines four power states: P0, P0s, P1, and P2.

The physical layer device must support these power states to minimize power consumption:

- P0 is the normal operating state during which packet data is transferred on the PCIe link.
- P0s, P1, and P2 are low-power states into which the physical layer must transition as directed by the PHY-MAC layer to minimize power consumption.

The PIPE interface in the transceivers provides an input port for each transceiver channel configured in a PIPE configuration.

Note: When transitioning from the P0 power state to lower power states (P0s, P1, and P2), the PCIe specification requires that the physical layer device implements power saving measures. The transceivers do not implement these power saving measures except to place the transmitter buffer in electrical idle in the lower power states.

8B/10B Encoder Usage for Compliance Pattern Transmission Support

The PCIe transmitter transmits a compliance pattern when the Link Training and Status State Machine (LTSSM) enters a polling compliance substate. The polling compliance substate assesses if the transmitter is electrically compliant with the PCIe voltage and timing specifications.

Receiver Status

The PCIe specification requires that the PHY encode the receiver status on a 3-bit status signal (`pipe_rxstatus[2:0]`).

This status signal is used by the PHY-MAC layer for its operation. The PIPE interface block receives the status signals from the transceiver channel PCS and PMA blocks, and encodes the status on the `pipe_rxstatus[2:0]` signal to the FPGA fabric. The encoding of the status signals on the `pipe_rxstatus[2:0]` signal is compliant with the PCIe specification.

Receiver Detection

The PIPE interface block in Cyclone V transceivers provides an input signal (`pipe_txdetectrx_loopback`) for the receiver detect operation that is required by the PCIe protocol during the detect substate of the LTSSM.

When the `pipe_txdetectrx_loopback` signal is asserted in the P1 power state, the PCIe interface block sends a command signal to the transmitter buffer in that channel to initiate a receiver detect sequence. In the P1 power state, the transmitter buffer must always be in the electrical idle state.

After receiving this command signal, the receiver detect circuitry creates a step voltage at the output of the transmitter buffer. If an active receiver that complies with the PCIe input impedance requirements is present at the far end, the time constant of the step voltage on the trace is higher than if the receiver is not present. The receiver detect circuitry monitors the time constant of the step signal that is seen on the trace to determine if a receiver was detected. The receiver detect circuitry monitor requires a 125-MHz clock for operation that you must drive on the `fixedclk` port.

Note: For the receiver detect circuitry to function reliably, the AC-coupling capacitor on the serial link and the receiver termination values used in your system must be compliant with the PCIe Base Specification 2.1.

The PCI Express PHY (PIPE) IP core provides a 1-bit PHY status (`pipe_phystatus`) and a 3-bit receiver status signal (`pipe_rxstatus[2:0]`) to indicate whether a receiver was detected or not, in accordance to the PIPE specifications.

Clock Rate Compensation Up to ± 300 ppm

In compliance with the PCIe protocol, the receiver channels are equipped with a rate match FIFO to compensate for the small clock frequency differences of up to ± 300 ppm between the upstream transmitter and local receiver clocks.

Related Information

[Transceiver Architecture in Cyclone V Devices](#)

PCIe Reverse Parallel Loopback

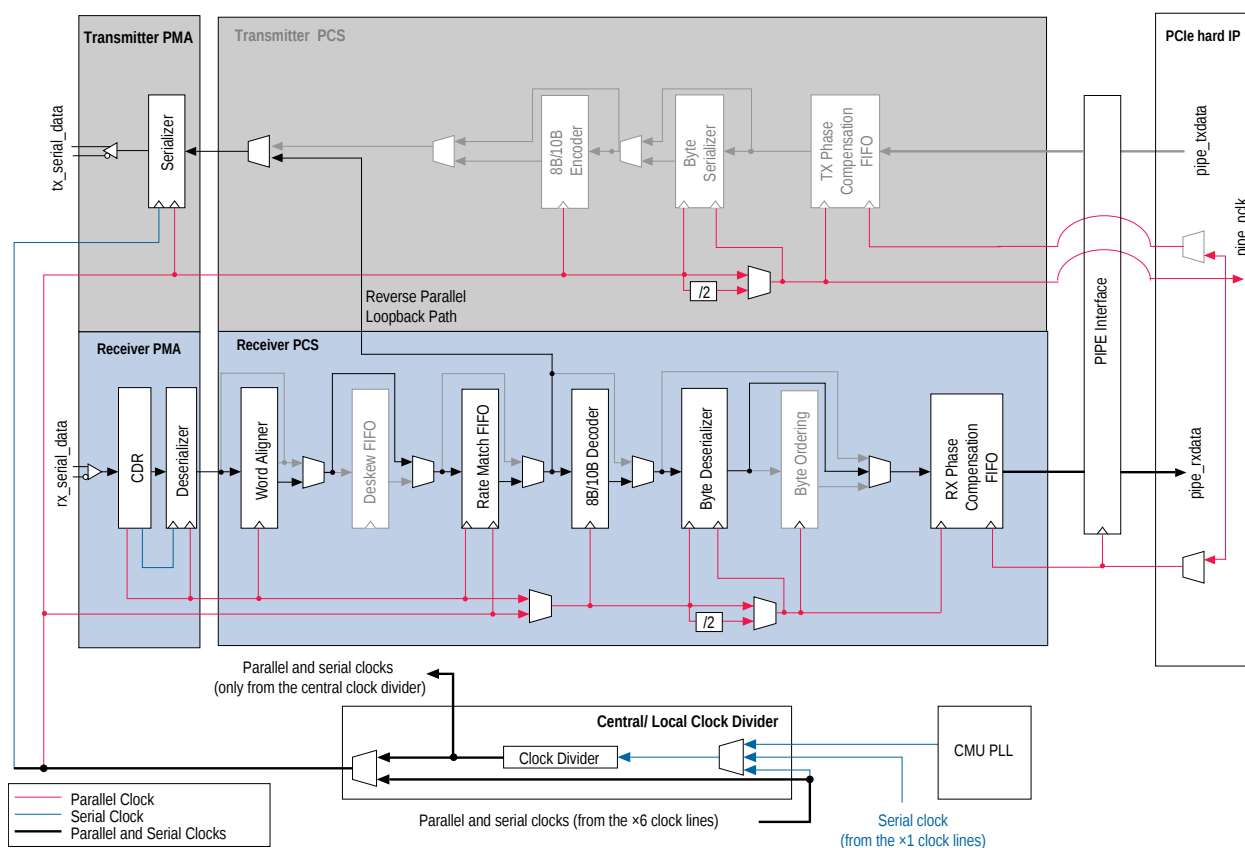
The PCIe reverse parallel loopback is only available in the PCIe functional configuration for the Gen1 data rate. The received serial data passes through the receiver CDR, deserializer, word aligner, and rate matching FIFO buffer. It is then looped back to the transmitter serializer and transmitted out through the transmitter buffer. The received data is also available to the FPGA fabric through the port.

PCIe reverse parallel loopback mode is compliant with PCIe specification 2.1.

Cyclone V devices provide the `pipe_txdetectrx_loopback` input signal to enable this loopback mode. If the `pipe_txdetectrx_loopback` signal is asserted in the P1 power state, receiver detection is performed. If the signal is asserted in the P0 power state, reverse parallel loopback is performed.

Note: The PCIe reverse parallel loopback is the only loopback option that is supported in PIPE configurations.

Figure 4-4: PIPE Reverse Parallel Loopback Mode Datapath



PCIe Supported Configurations and Placement Guidelines

Placement by the Quartus II software may vary with design and device. The following figures show examples of transceiver channel and PCIe Hard IP block locations, supported x1, x2, and x4 bonding configurations, and channel placement guidelines. The Quartus II software automatically places the CMU PLL in a channel different from that of the data channels.

Note: This section shows the supported PCIe channel placement if you use both the top and bottom PCIe Hard IP blocks in the device separately.

In the following figures, channels shaded in blue provide the high-speed serial clock. Channels shaded in gray are data channels.

Figure 4-5: 12 Transceiver Channels and 2 PCIe HIP Blocks with PCIe x2 and x4 Channel Placement

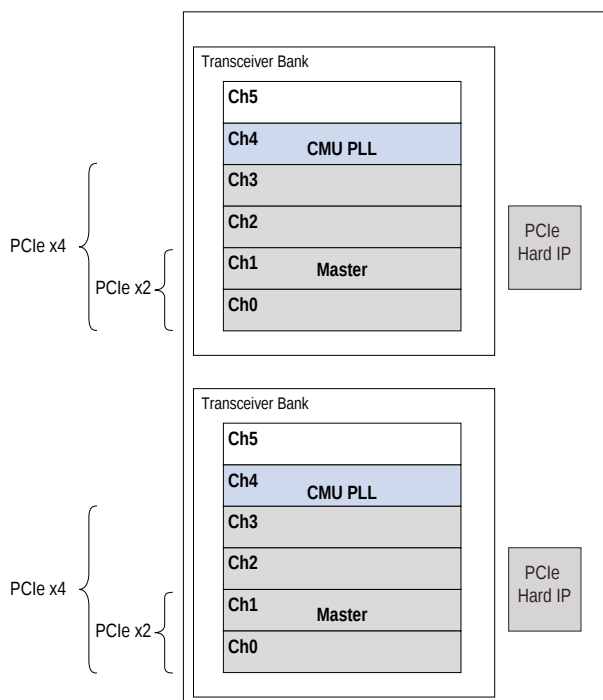


Figure 4-6: 12 Transceiver Channels and 2 PCIe HIP Blocks with PCIe x1 Channel Placement

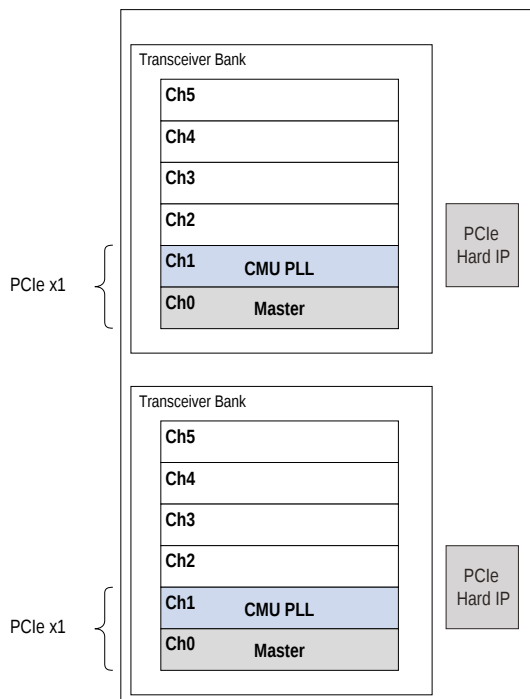


Figure 4-7: 9 Transceiver Channels and 2 PCIe HIP Blocks with PCIe x2 and x4 Channel Placement

The grayed out PCIe Hard IP block is not used in this example

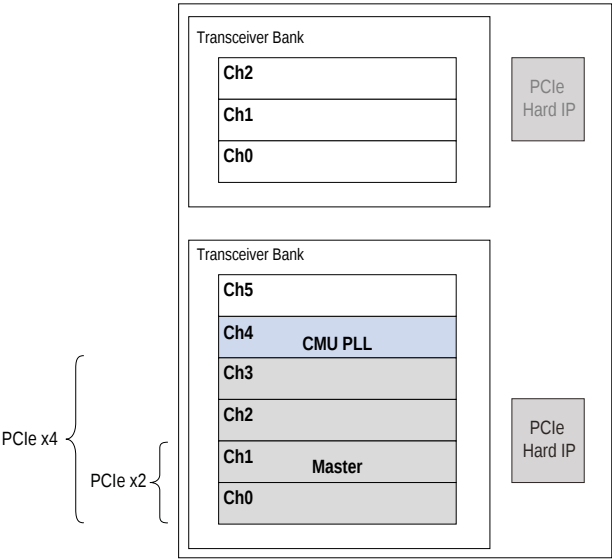


Figure 4-8: 9 Transceiver Channels and 2 PCIe HIP Blocks with PCIe x1 Channel Placement

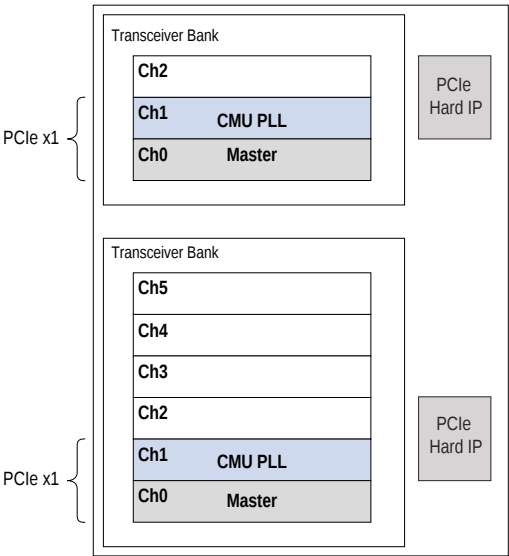
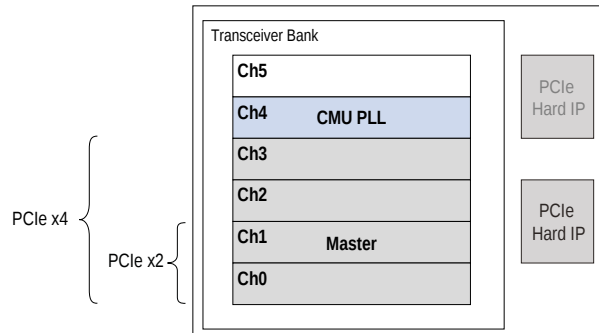
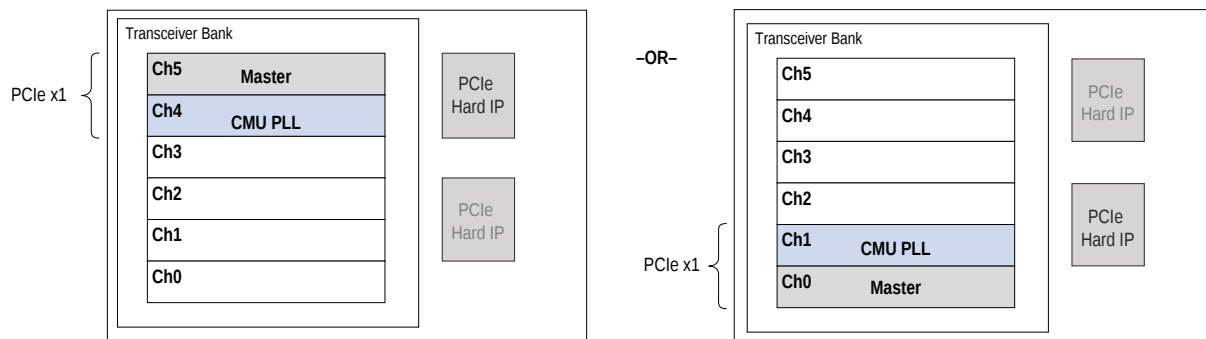
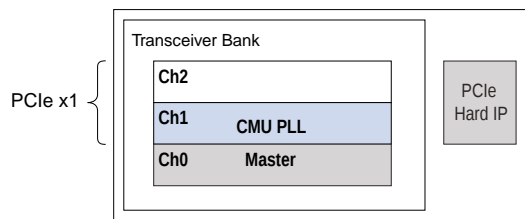


Figure 4-9: 6 Transceiver Channels and 1 PCIe HIP Blocks with PCIe x2 and x4 Channel Placement

The grayed out PCIe Hard IP block is not used in this example.

**Figure 4-10: 6 Transceiver Channels and 2 PCIe HIP with PCIe x1 Channel Placement**

The grayed out PCIe Hard IP block is not used in this example.

**Figure 4-11: 3 Transceiver Channels and 1 PCIe HIP Blocks with PCIe x1 Channel Placement**

For PCIe Gen1 and Gen2, there are restrictions on the achievable x1 and x4 bonding configurations if you intend to use both top and bottom Hard IP blocks in the device.

Table 4-2: Hard IP Configurations for PCIe Gen1 and Gen2

The following table lists the configurations allowed for each Cyclone V device when you use both PCIe Hard IP blocks on the top and bottom transceiver banks. Support will vary by the number of transceiver channels in a device.

Top PCIe Hard IP	Bottom PCIe Hard IP	5CGXC4, 5CGXC5, 5CGTD5, 5CSXC5, 5CSTD5	5CGXC7, 5CGTD7, 5CSXC6, 5CSTD6	5CGXC9, 5CGTD9
x1	x1	Yes	Yes	Yes
	x2	No	Yes	Yes
	x4	No	Yes	Yes
x2	x1	No	No	Yes
	x2	No	No	Yes
	x4	No	No	Yes
x4	x1	No	No	Yes
	x2	No	No	Yes
	x4	No	No	Yes

The following table lists the maximum number of data channels that can be enabled to ensure the channels meet the PCIe Gen2 Transmit Jitter Specification. Follow this recommendation when planning channel placement for PCIe Gen2 using Cyclone V GT or Cyclone V ST device variants.

Table 4-3: Recommended Channel Placement for PCIe Gen2

CMU channels are not counted as data channels.

Device	Maximum Channels Utilization
5CGTD7F672, 5CGTD7F896, 5CGTD9F672, 5CSTD5F896, 5CSTD6F896	6
5CGTD9F896, 5CGTD9F1152	8

Related Information

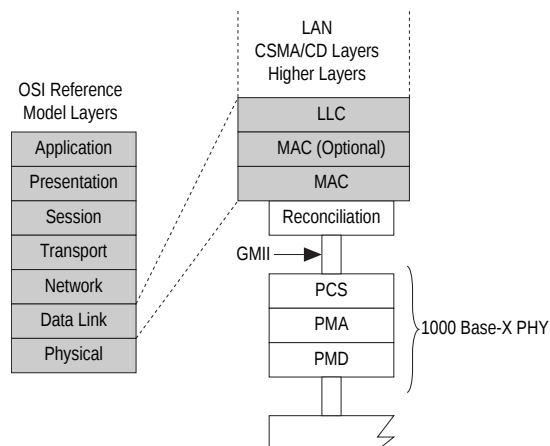
[Transceiver Architecture in Cyclone V Devices](#)

Gigabit Ethernet

The IEEE 802.3 specification defines the 1000BASE-X PHY as an intermediate, or transition layer that interfaces various physical media with the MAC in a gigabit ethernet (GbE) system, shielding the MAC layer from the specific nature of the underlying medium. The 1000BASE-X PHY is divided into the PCS, PMA, and PMD sublayers.

The PCS sublayer interfaces with the MAC through the gigabit media independent interface (GMII). The 1000BASE-X PHY defines a physical interface data rate of 1 Gbps and 2.5 Gbps.

Figure 4-12: 1000BASE-X PHY in a GbE OSI Reference Model

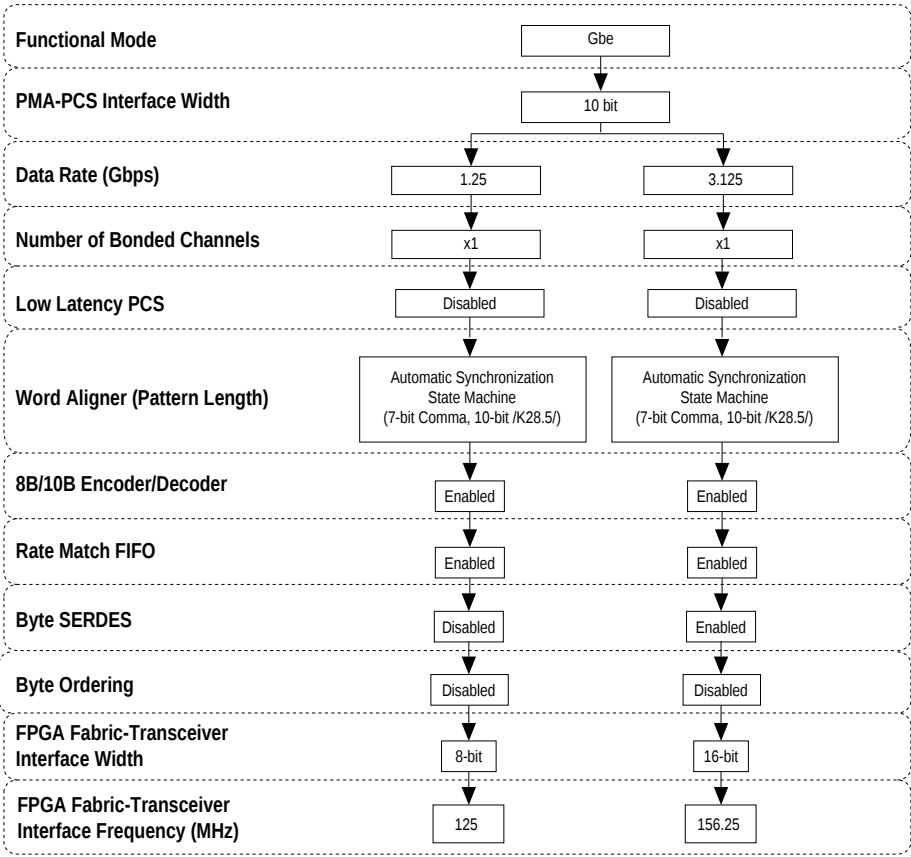


The transceivers, when configured in GbE functional mode, have built-in circuitry to support the following PCS and PMA functions, as defined in the IEEE 802.3 specification:

- 8B/10B encoding and decoding
- Synchronization
- Upstream transmitter and local receiver clock frequency compensation (rate matching)
- Clock recovery from the encoded data forwarded by the receiver PMD
- Serialization and deserialization

Note: The transceivers do not have built-in support for other PCS functions, such as the autonegotiation state machine, collision-detect, and carrier-sense functions. If you require these functions, implement them in the FPGA fabric or in external circuits.

Figure 4-13: Transceiver Blocks in a GbE Configuration



Gigabit Ethernet Transceiver Datapath

Figure 4-14: Transceiver Datapath in GbE-1.25 Gbps Configuration

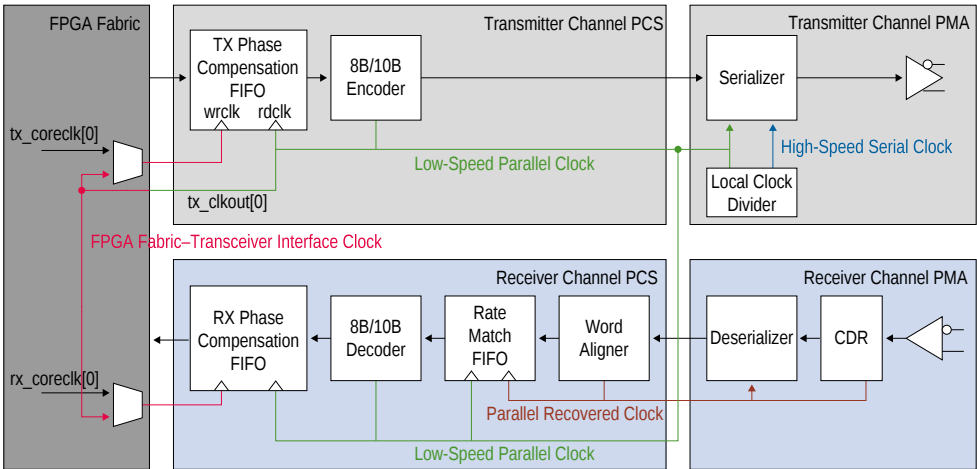


Figure 4-15: Transceiver Datapath in GbE-3.125 Gbps Configuration

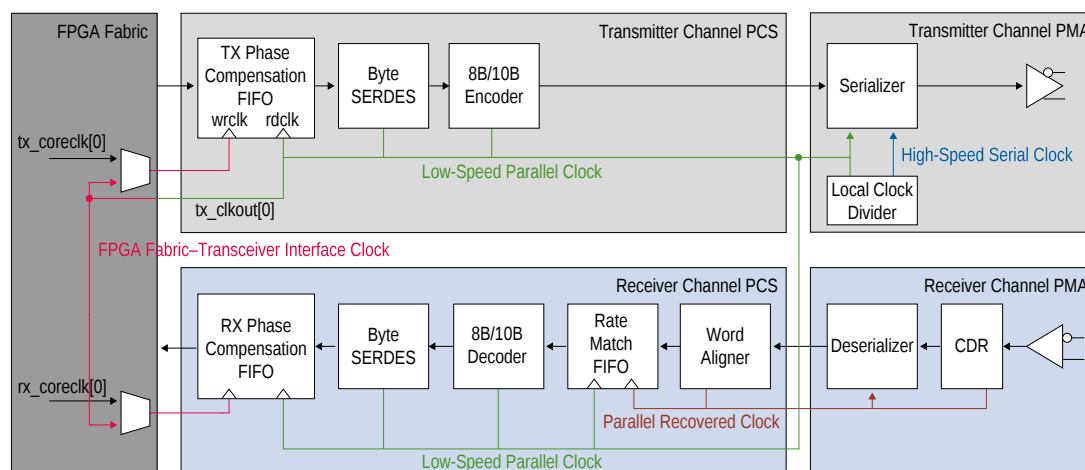


Table 4-4: Transceiver Datapath Clock Frequencies in GbE Configuration

Functional Mode	Data Rate	High-Speed Serial Clock Frequency	Parallel Recovered Clock and Low-Speed Parallel Clock Frequency	FPGA Fabric-Transceiver Interface Clock Frequency
GbE-1.25 Gbps	1.25 Gbps	625 MHz	125 MHz	125 MHz
GbE-3.125 Gbps	3.125 Gbps	1562.5 MHz	312.5 MHz	156.25 MHz

8B/10B Encoder

In GbE configuration, the 8B/10B encoder clocks in 8-bit data and 1-bit control identifiers from the transmitter phase compensation FIFO and generates 10-bit encoded data. The 10-bit encoded data is fed to the serializer.

For more information about the 8B/10B encoder functionality, refer to the [Transceiver Architecture for Cyclone V Devices](#) chapter.

Rate Match FIFO

In GbE configuration, the rate match FIFO is capable of compensating for up to ± 100 ppm (200 ppm total) difference between the upstream transmitter and the local receiver reference clock. The GbE protocol requires that the transmitter send idle ordered sets /I1/ (/K28.5/D5.6/) and /I2/ (/K28.5/D16.2/) during interpacket gaps, adhering to the rules listed in the IEEE 802.3 specification.

The rate match operation begins after the synchronization state machine in the word aligner indicates that the synchronization is acquired-by driving the rx_syncstatus signal high. The rate matcher always deletes or inserts both symbols (/K28.5/ and /D16.2/) of the /I2/ ordered sets, even if only one symbol needs to be deleted to prevent the rate match FIFO from overflowing or underrunning. The rate matcher can insert or delete as many /I2/ ordered sets as necessary to perform the rate match operation.

Two flags are forwarded to the FPGA fabric:

- `rx_rmfi_fodata_deleted` - Asserted for two clock cycles for each deleted /I2/ ordered set to indicate the rate match FIFO deletion event
- `rx_rmfi_fodata_inserted` - Asserted for two clock cycles for each inserted /I2/ ordered set to indicate the rate match FIFO insertion event

For more information about the rate match FIFO, refer to the [Transceiver Architecture for Cyclone V Devices](#) chapter.

GbE Protocol-Ordered Sets and Special Code Groups

Table 4-5: GIGE Ordered Sets

The following ordered sets and special code groups are specified in the IEEE 802.3-2008 specification.

Code	Ordered Set	Number of Code Groups	Encoding
/C/	Configuration	—	Alternating /C1/ and /C2/
/C1/	Configuration 1	4	/K28.5/D21.5/ Config_Reg ⁽¹²⁾
/C2/	Configuration 2	4	/K28.5/D2.2/ Config_Reg
/I/	IDLE	—	Correcting /I1/, Preserving /I2/
/I1/	IDLE 1	2	/K28.5/D5.6/
/I2/	IDLE 2	2	/K28.5/D16.2/
-	Encapsulation	—	—
/R/	Carrier_Extend	1	/K23.7/
/S/	Start_of_Packet	1	/K27.7/
/T/	End_of_Packet	1	/K29.7/
/V/	Error_Propagation	1	/K30.7/

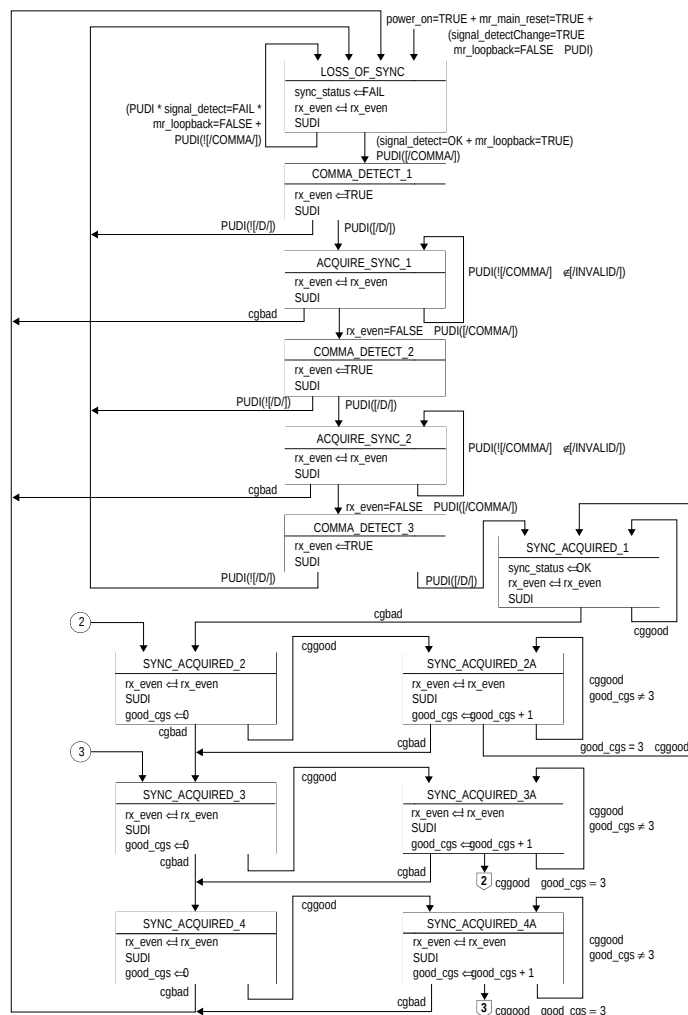
Table 4-6: Synchronization State Machine Parameters in GbE Mode

Synchronization State Machine Parameters	Setting
Number of valid {/K28.5/, /Dx,y/} ordered sets received to achieve synchronization	3
Number of errors received to lose synchronization	4
Number of continuous good code groups received to reduce the error count by 1	4

⁽¹²⁾ Two data code groups represent the Config_Reg value.

Figure 4-16: Synchronization State Machine in GbE Mode

This figure is from “Figure 36–9” in the IEEE 802.3-2008 specification. For more details about the 1000BASE-X implementation, refer to Clause 36 of the IEEE 802.3-2008 specification.



Related Information

Refer to the "Custom PHY IP Core" and "Native PHY IP Core" chapters in the Altera Transceiver PHY IP Core User Guide

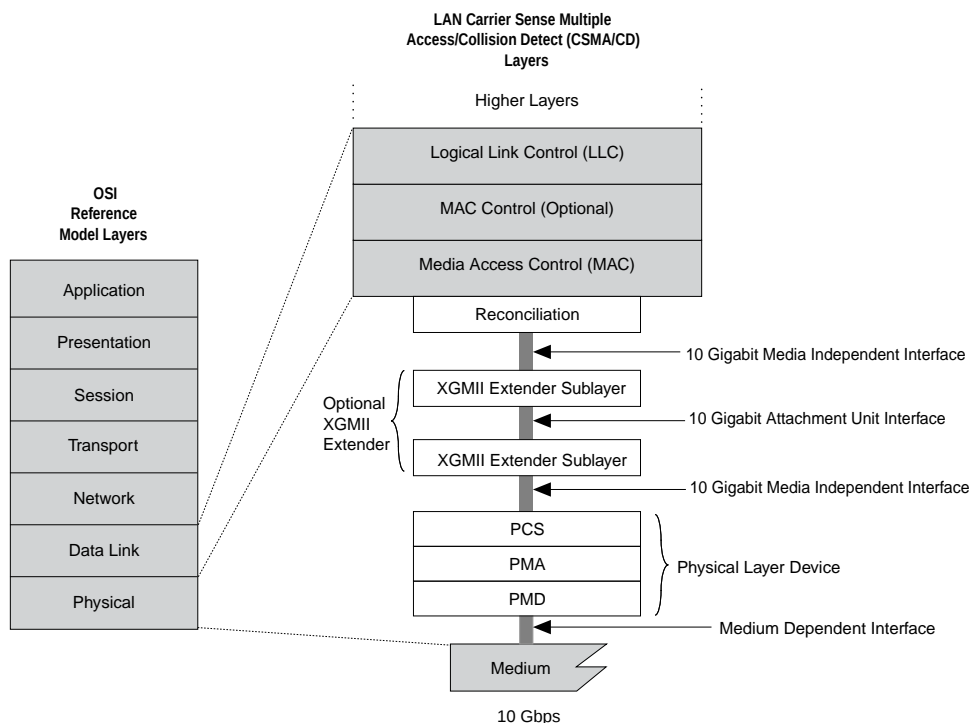
XAU

In a XAUI configuration, the transceiver channel data path is configured using soft PCS. It provides the transceiver channel datapath description, clocking, and channel placement guidelines. With the MegaWizard Plug-In Manager, you can implement a XAUI link. Under Ethernet in the Interfaces menu, select the XAUI PHY IP core. The XAUI PHY IP core implements the XAUI PCS in soft logic.

XAUI is a specific physical layer implementation of the 10 Gigabit Ethernet link defined in the IEEE 802.3ae-2002 specification. The XAUI PHY uses the XGMII interface to connect to the IEEE802.3 MAC and

Reconciliation Sublayer (RS). The IEEE 802.3ae-2002 specification requires the XAUI PHY link to support a 10 Gbps data rate at the XGMII interface and four lanes each at 3.125 Gbps at the PMD interface.

Figure 4-17: XAUI and XGMII Layers



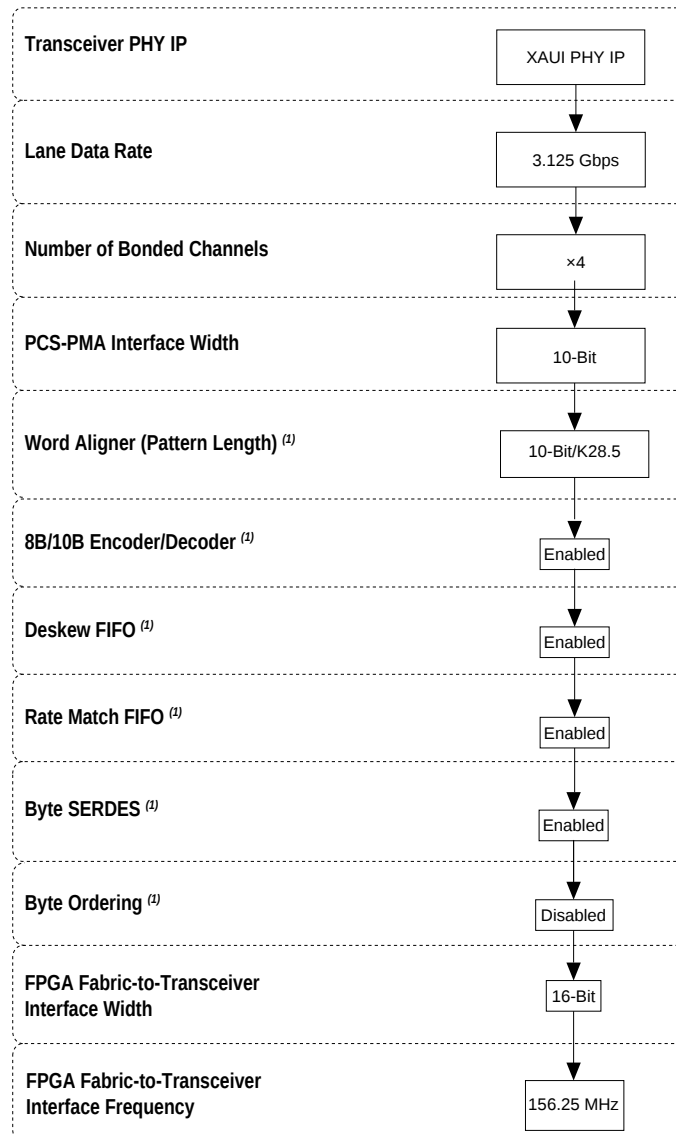
Related Information

Refer to the "XAUI PHY IP Core" chapter in the [Altera Transceiver PHY IP Core User Guide](#).

Transceiver Datapath in a XAUI Configuration

The XAUI PCS is implemented in soft logic inside the FPGA core when using the XAUI PHY IP core. You must ensure that your channel placement is compatible with the soft PCS implementation.

Figure 4-18: XAUI Configuration Datapath

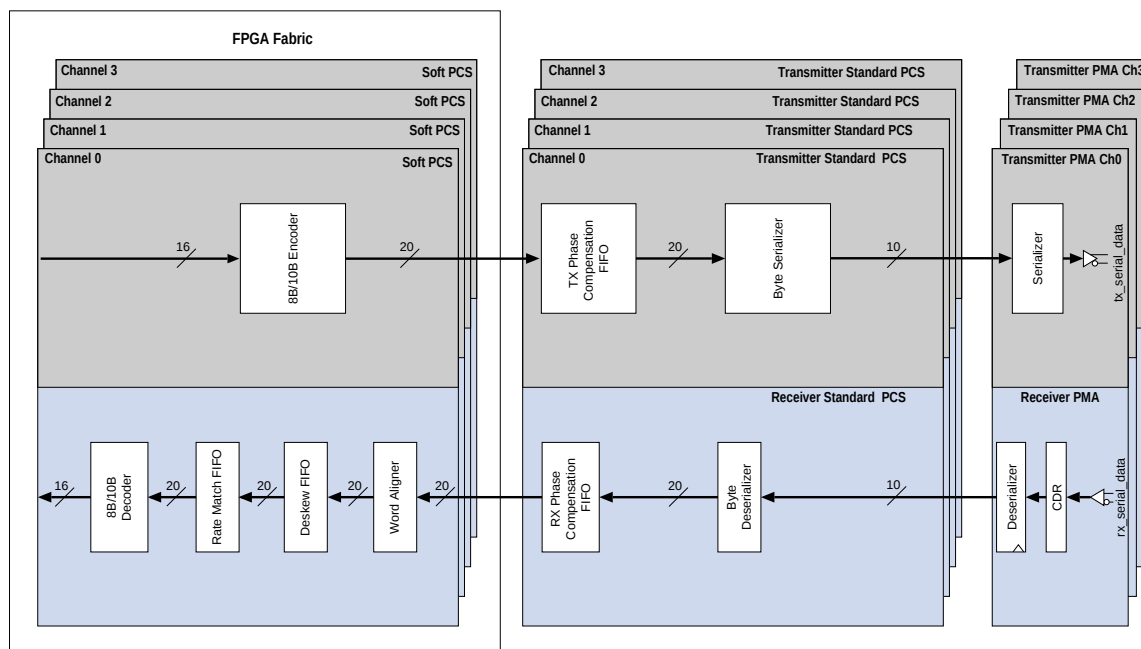


Note:

1. Implemented in soft logic.

Figure 4-19: Transceiver Channel Datapath for XAUI Configuration

Standard PCS in a low latency configuration is used in this configuration. Additionally, a portion of the PCS is implemented in soft logic.

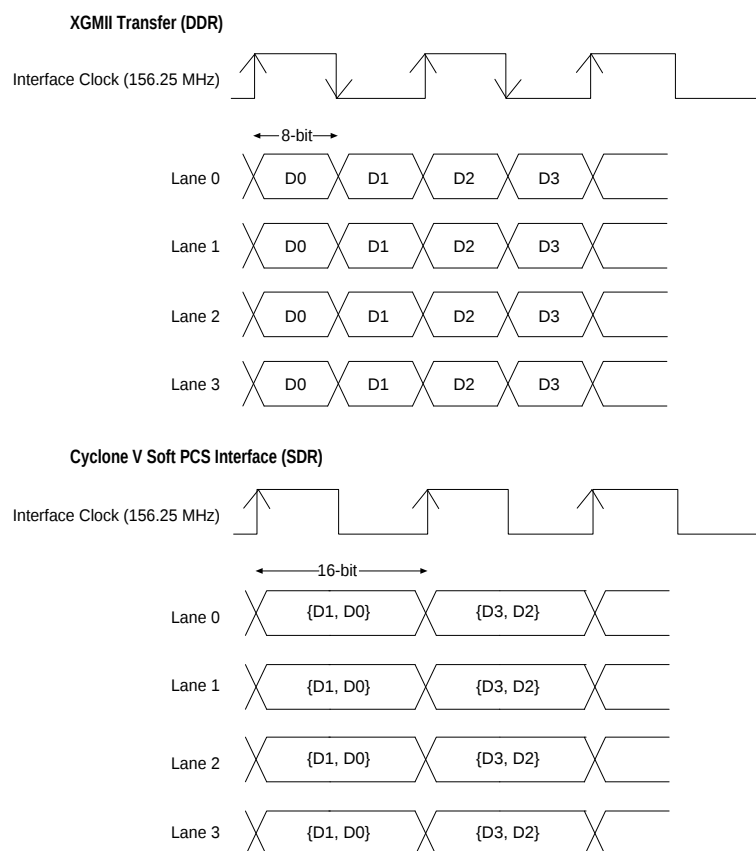


XAUI Supported Features

64-Bit SDR Interface to the MAC/RS

Clause 46 of the IEEE 802.3-2008 specification defines the XGMII interface between the XAUI PCS and the Ethernet MAC/RS. The specification requires each of the four XAUI lanes to transfer 8-bit data and 1-bit wide control code at both the positive and negative edge (DDR) of the 156.25 MHz interface clock.

Cyclone V transceivers and soft PCS solution in a XAUI configuration do not support the XGMII interface to the MAC/RS as defined in IEEE 802.3-2008 specification. Instead, they allow the transferring of 16-bit data and 2-bit control code on each of the four XAUI lanes, only at the positive edge (SDR) of the 156.25 MHz interface clock

Figure 4-20: Implementation of the XGMII Specification in Cyclone V Devices Configuration

8B/10B Encoding/Decoding

Each of the four lanes in a XAUI configuration support an independent 8B/10B encoder/decoder as specified in Clause 48 of the IEEE802.3-2008 specification. 8B/10B encoding limits the maximum number of consecutive 1s and 0s in the serial data stream to five, thereby ensuring DC balance as well as enough transitions for the receiver CDR to maintain a lock to the incoming data.

The XAUI PHY IP core provides status signals to indicate running disparity as well as the 8B/10B code group error.

Transmitter and Receiver State Machines

In a XAUI configuration, the Cyclone V soft PCS implements the transmitter and receiver state diagrams shown in Figure 48-6 and Figure 48-9 of the IEEE802.3-2008 specification.

In addition to encoding the XGMII data to PCS code groups, in conformance with the 10GBASE-X PCS, the transmitter state diagram performs functions such as converting Idle ||I|| ordered sets into Sync ||K||, Align ||A||, and Skip ||R|| ordered sets.

In addition to decoding the PCS code groups to XGMII data, in conformance with the 10GBASE-X PCS, the receiver state diagram performs functions such as converting Sync ||K||, Align ||A||, and Skip ||R|| ordered sets to Idle ||I|| ordered sets.

Synchronization

The word aligner block in the receiver PCS of each of the four XAUI lanes implements the receiver synchronization state diagram shown in Figure 48-7 of the IEEE802.3-2008 specification.

The XAUI PHY IP core provides a status signal per lane to indicate if the word aligner is synchronized to a valid word boundary.

Deskew

The lane aligner block in the receiver PCS implements the receiver deskew state diagram shown in Figure 48-8 of the IEEE 802.3-2008 specification.

The lane aligner starts the deskew process only after the word aligner block in each of the four XAUI lanes indicates successful synchronization to a valid word boundary.

The XAUI PHY IP core provides a status signal to indicate successful lane deskew in the receiver PCS.

Clock Compensation

The rate match FIFO in the receiver PCS datapath compensates up to ± 100 ppm difference between the remote transmitter and the local receiver. It does so by inserting and deleting Skip $||R||$ columns, depending on the ppm difference.

The clock compensation operation begins after:

- The word aligner in all four XAUI lanes indicates successful synchronization to a valid word boundary.
- The lane aligner indicates a successful lane deskew.

The rate match FIFO provides status signals to indicate the insertion and deletion of the Skip $||R||$ column for clock rate compensation.

Transceiver Clocking and Channel Placement Guidelines in XAUI Configuration

Transceiver Clocking

Figure 4-21: Transceiver Clocking for XAUI Configuration

One of the two channel PLLs configured as a CMU PLL in a transceiver bank generates the transmitter serial and parallel clocks for the four XAUI channels. The x6 clock line carries the transmitter clocks to the PMA and PCS of each of the four channels.

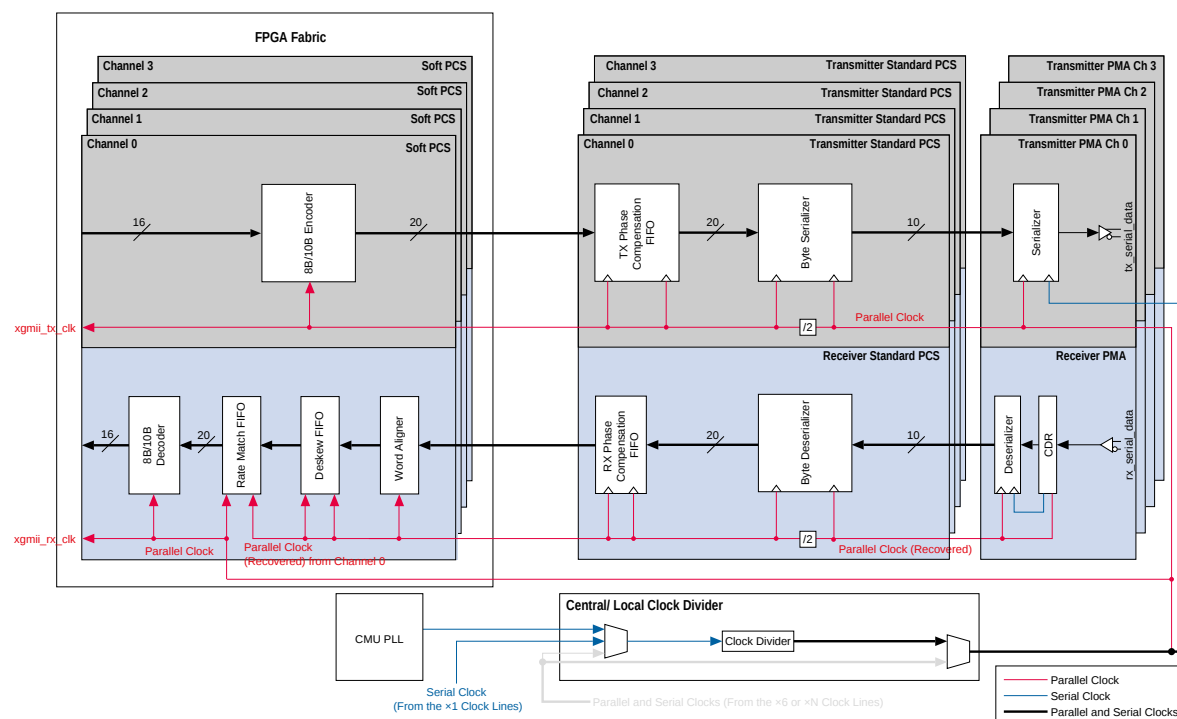


Table 4-7: Input Reference Clock Frequency and Interface Speed Specifications for XAUI Configurations

Input Reference Clock Frequency (MHz)	FPGA Fabric-Transceiver Interface Width	FPGA Fabric-Transceiver Interface Frequency (MHz)
156.25	16-bit data, 2-bit control	156.25

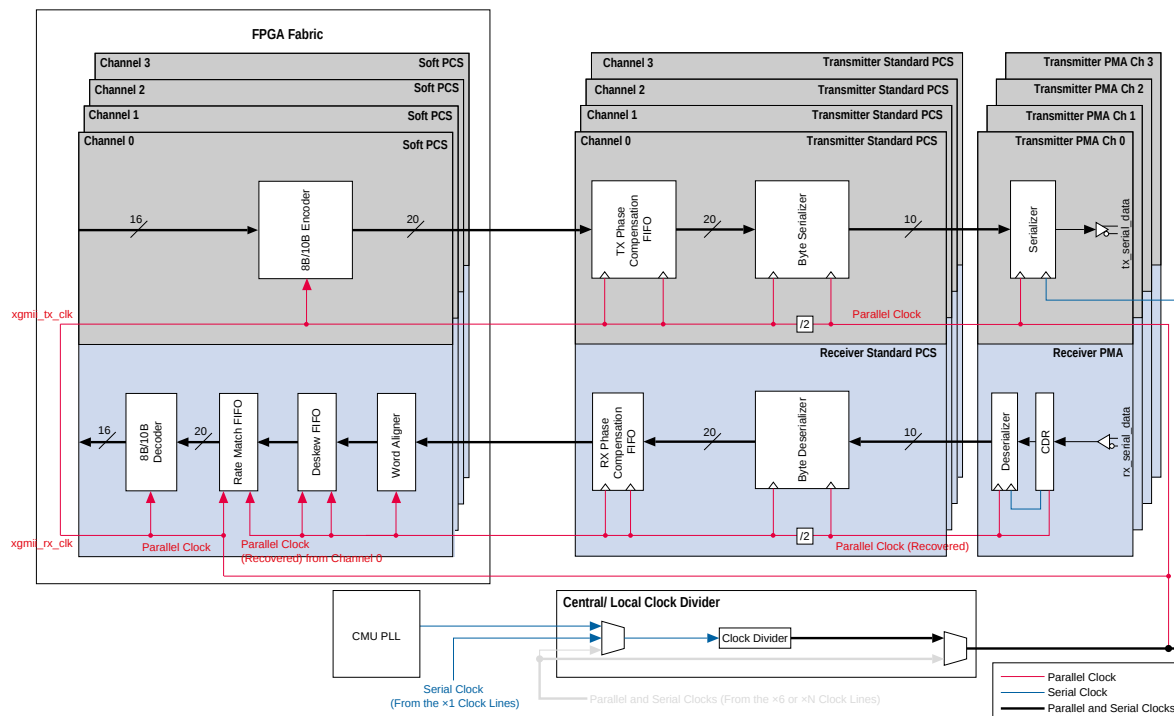
Transceiver Clocking Guidelines for Soft PCS Implementation

In the soft PCS implementation in the XAUI configuration, you must route `xgmii_rx_clk` to `xgmii_tx_clk` as shown in the following figure.

This method uses `xgmii_rx_clk` to compensate for the phase difference on the TX side.

Without this method, the `tx_digitalreset` signal may experience intermittent failure.

Figure 4-22: Transceiver Clocking for XAUI Soft PCS Implementation

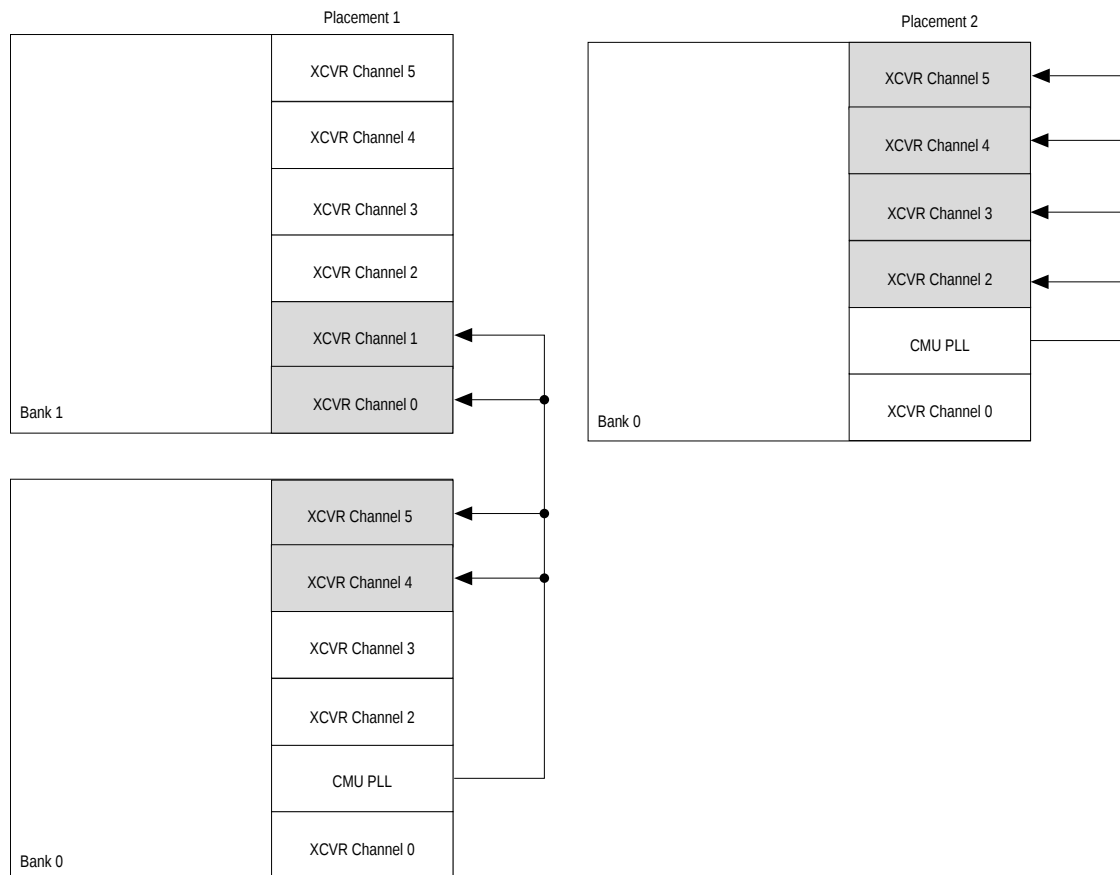


Transceiver Channel Placement Guidelines

In the soft PCS implementation of the XAUI configuration, all four channels must be placed continuously. The channels may all be placed in one bank or they may span two banks. Only the placements shown in the following figure are allowed.

Figure 4-23: Transceiver Channel Placement Guidelines in a XAUI Configuration

Use one of the two allowed channel placements when using the CMU PLL to drive the XAUI link. The Quartus II software implements the XAUI PCS in soft logic.

**Related Information**

To implement the QSF assignment workaround using the Assignment Editor, refer to the "XAUI PHY IP Core" chapter in the Altera Transceiver PHY IP Core User Guide.

Serial Digital Interface

The Society of Motion Picture and Television Engineers (SMPTE) defines various Serial Digital Interface (SDI) standards for transmission of uncompressed video.

The following SMPTE standards are popular in video broadcasting applications:

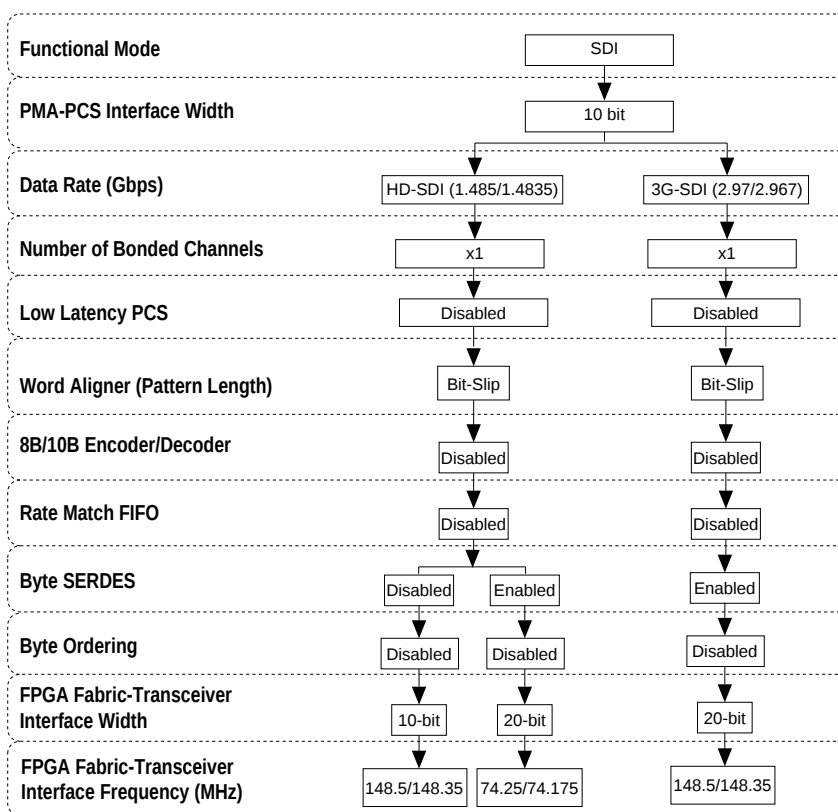
- SMPTE 259M standard - more popularly known as the standard-definition (SD) SDI; defined to carry video data at 270 Mbps
- SMPTE 292M standard - more popularly known as the high-definition (HD) SDI; defined to carry video data at either 1485 Mbps or 1483.5 Mbps
- SMPTE 424M standard - more popularly known as the third-generation (3G) SDI; defined to carry video data at either 2970 Mbps or 2967 Mbps

Configurations Supported in SDI Mode

Table 4-8: Configurations Supported in SDI Mode

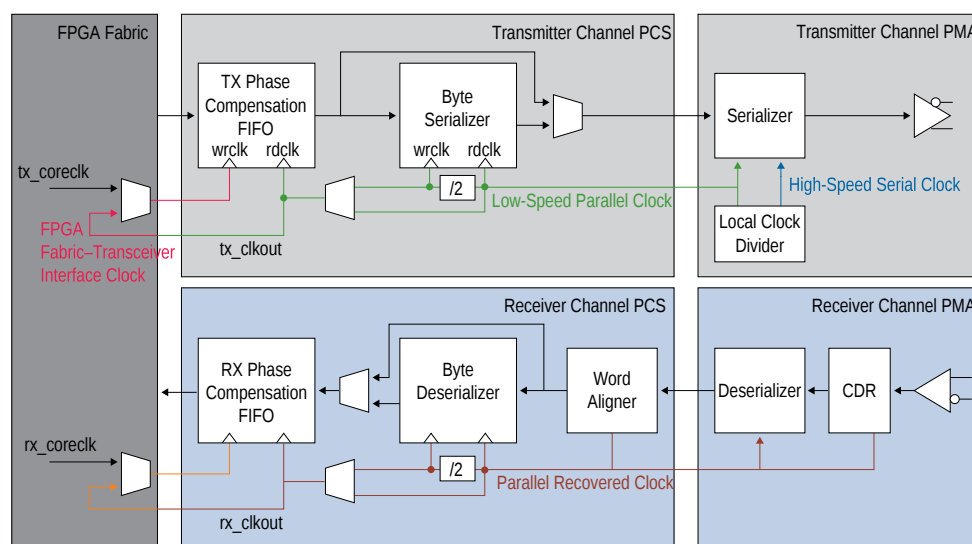
Configuration	Data Rate (Mbps)	REFCLK Frequencies (MHz)	FPGA Fabric-Transceiver Interface Width
HD	1,485	74.25, 148.5	10 bit and 20 bit
	1,483.5	74.175, 148.35	10 bit and 20 bit
3G	2,970	148.5, 297	Only 20-bit interfaces allowed in 3G
	2,967	148.35, 296.7	Only 20-bit interfaces allowed in 3G

Figure 4-24: SDI Mode



Serial Digital Interface Transceiver Datapath

Figure 4-25: SDI Mode Transceiver Datapath



Transmitter Datapath

The transmitter datapath in the HD-SDI configuration with a 10-bit wide FPGA fabric-transceiver interface consists of the transmitter phase compensation FIFO and the 10:1 serializer. In HD-SDI and 3G-SDI configurations with 20-bit wide FPGA fabric-transceiver interface, the transmitter datapath also includes the byte serializer.

Note: In SDI mode, the transmitter is purely a parallel-to-serial converter. You must implement the SDI transmitter functions, such as the scrambling and cyclic redundancy check (CRC) code generation, in the FPGA logic array.

Receiver Datapath

In the 10-bit channel width SDI configuration, the receiver datapath consists of the clock recovery unit (CRU), 1:10 deserializer, word aligner in bit-slip mode, and receiver phase compensation FIFO. In the 20-bit channel width SDI configuration, the receiver datapath also includes the byte deserializer.

Note: You must implement the SDI receiver functions, such as descrambling, framing, and CRC checker, in the FPGA logic array.

Receiver Word Alignment and Framing

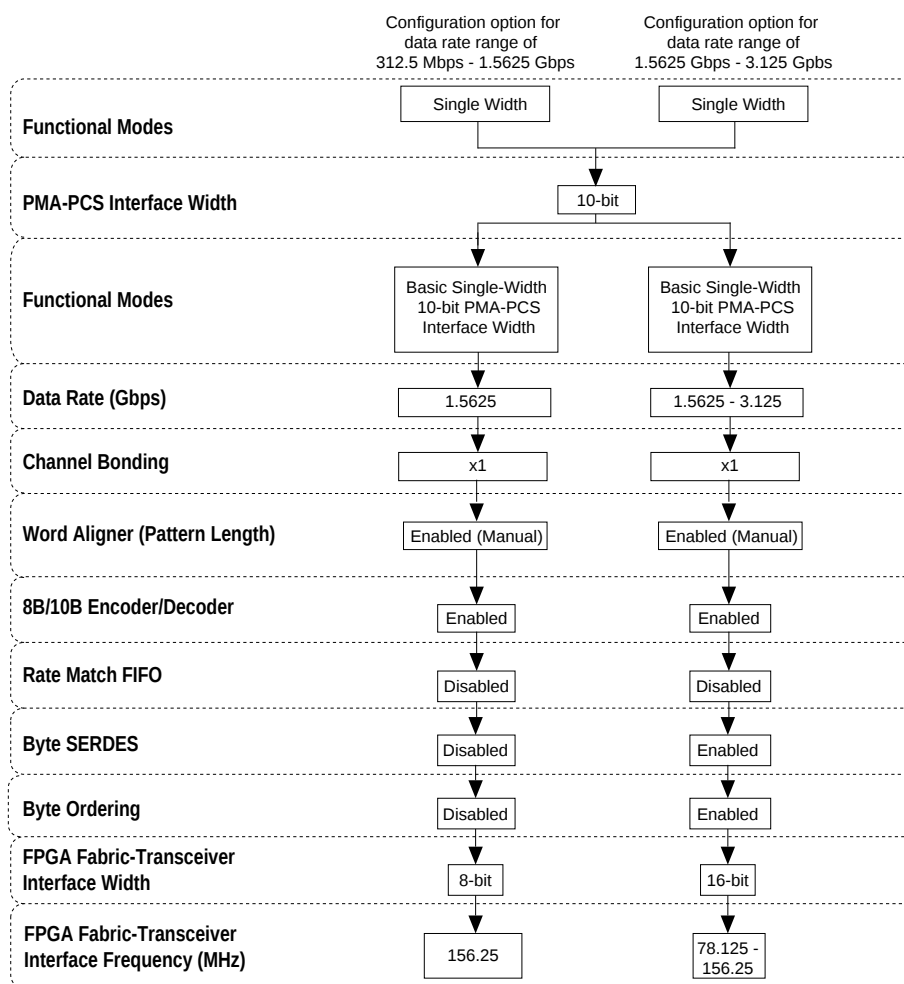
In SDI systems, the word aligner in the receiver datapath is not useful because the word alignment and framing happen after descrambling. Altera recommends that you drive the `rx_bitslip` of the PHY MegaWizard™ signal low to avoid having the word aligner insert bits in the received data stream.

Serial Data Converter (SDC) JESD204

The SDC (JESD204) protocol conforms to JESD204, a JEDEC standard that enables a high-speed serial connection between analog-to-digital converters and logic devices using only a two-wire high-speed serial

interface. SDC (JESD204) data rate ranges of 312.5 Mbps to 3.125 Gbps are supported. The minimum supported data rate is 611 Mbps, so a 5x oversampling factor is used for the SDC (JESD204) data rate of 312.5 Mbps, resulting in a data rate of 1.5625 Gbps.

Figure 4-26: Configurations for the SDC (JESD204) Protocol



SATA and SAS Protocols

Serial ATA (SATA) and Serial Attached SCSI (SAS) are data storage protocol standards that have the primary function of transferring data (directly or otherwise) between the host system and mass storage devices, such as hard disk drives, optical drives, and solid-state disks.

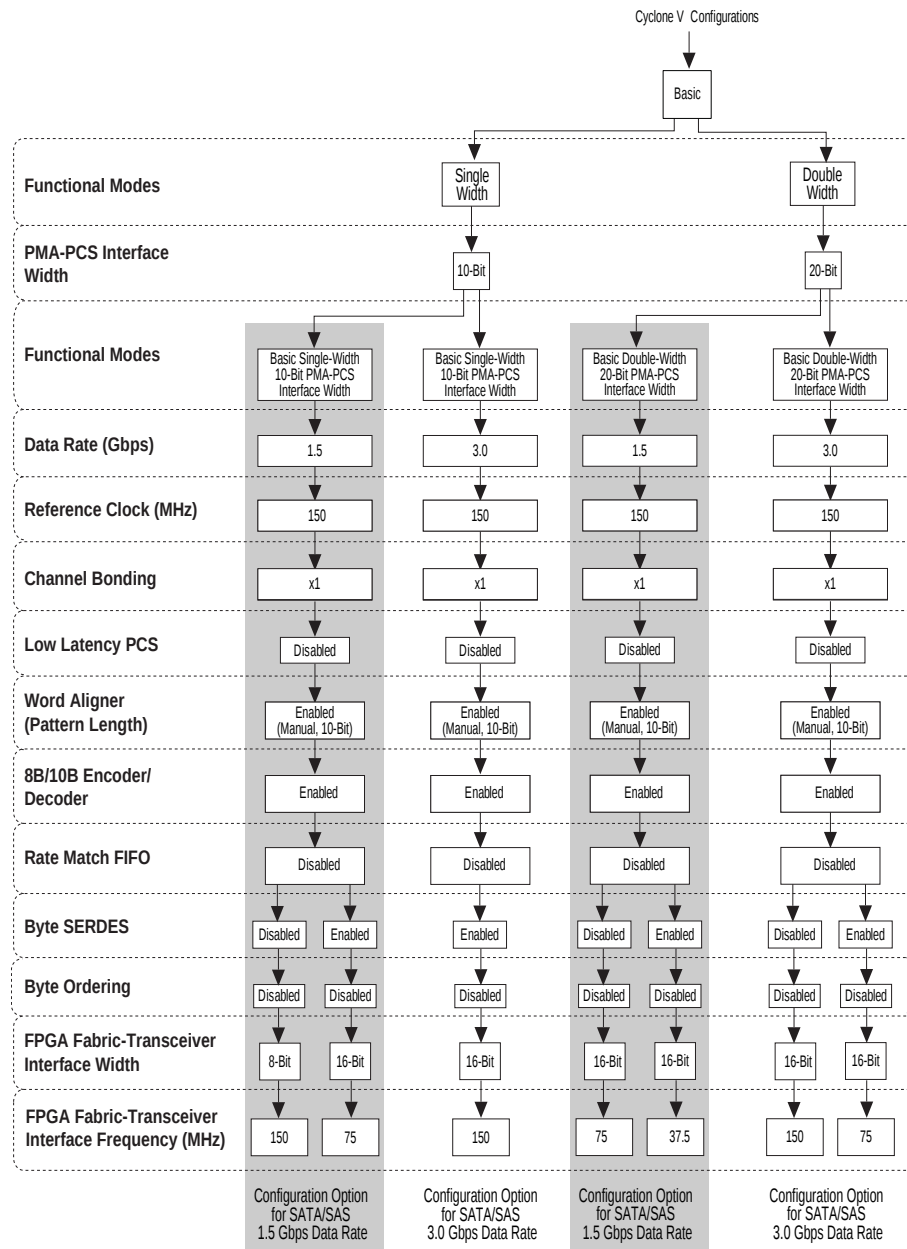
These serial storage protocols offer several advantages over older parallel storage protocol (ATA and SCSI) interfaces:

- Faster data transfer
- Hot swapping (when supported by the operating system)
- Thinner cables for more efficient air cooling
- Increased operation reliability

Table 4-9: Serial Data Rates for SATA and SAS Protocols

Protocol	SATA (Gbps)	SAS (Gbps)
Gen1	1.5	3.0
Gen2	3.0	—

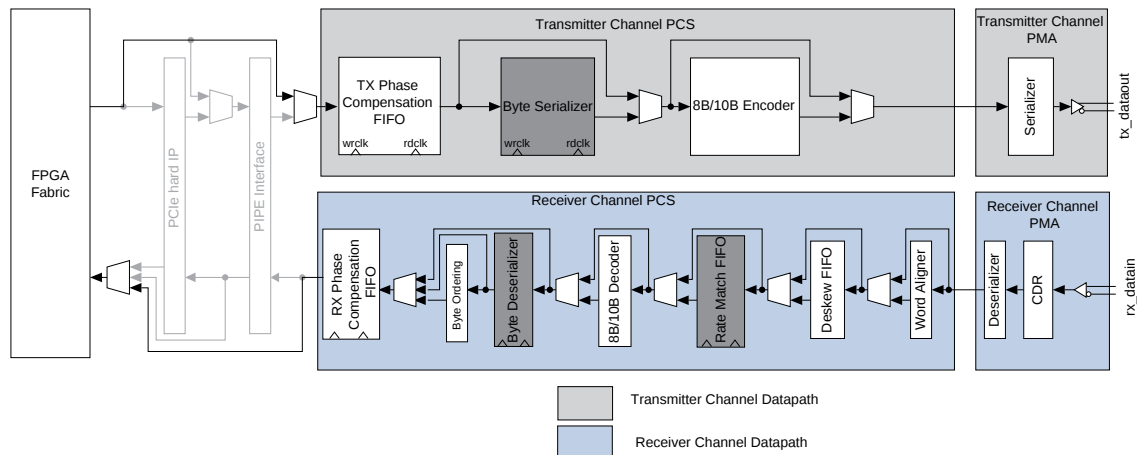
Figure 4-27: Configurations for the SATA and SAS Protocols



Deterministic Latency Protocols—CPRI and OBSAI

A deterministic latency option is available for use in high-speed serial interfaces such as the Common Public Radio Interface (CPRI) and OBSAI Reference Point 3 (OBSAI RP3). Both CPRI and OBSAI RP3 protocols place stringent requirements on the amount of latency variation that is permissible through a link that implements these protocols.

Figure 4-28: Transceiver Datapath in Deterministic Latency Mode



Latency Uncertainty Removal with the Phase Compensation FIFO in Register Mode

To remove the latency uncertainty through the receiver's phase compensation FIFO, the receiver and transmitter phase compensation FIFOs are always set to register mode. In register mode, the phase compensation FIFO acts as a register and thereby removes the uncertainty in latency. The latency through the transmitter and receiver phase compensation FIFO in register mode is one clock cycle.

The following options are available:

- Single-width mode with 8-bit channel width and 8B/10B encoder enabled or 10-bit channel width with 8B/10B disabled
- Double-width mode with 16-bit channel width and 8B/10B encoder enabled or 20-bit channel width with 8B/10B disabled

Channel PLL Feedback for Deterministic Relationship

To implement the deterministic latency functional mode, the phase relationship between the low-speed parallel clock and channel PLL input reference clock must be deterministic. A feedback path is enabled to ensure a deterministic relationship between the low-speed parallel clock and channel PLL input reference clock.

To achieve deterministic latency through the transceiver, the reference clock to the channel PLL must be the same as the low-speed parallel clock. For example, if you need to implement a data rate of 1.2288 Gbps for the CPRI protocol, which places stringent requirements on the amount of latency variation, you must choose a reference clock of 122.88 MHz to allow the usage of a feedback path from the channel PLL. This feedback path reduces the variations in latency.

When you select this option, provide an input reference clock to the channel PLL that has the same frequency as the low-speed parallel clock.

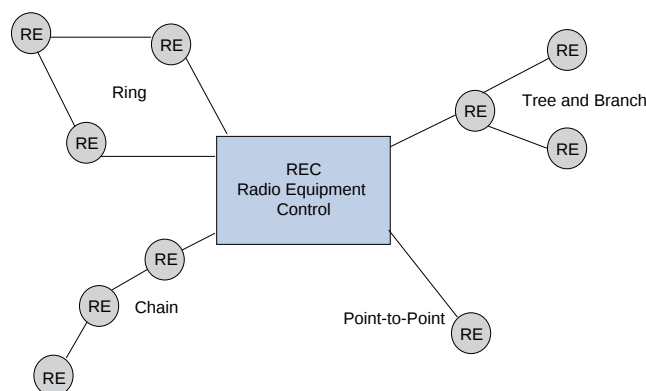
CPRI and OBSAI

Use the deterministic latency functional mode to implement protocols such as CPRI and OBSAI.

The CPRI interface defines a digital point-to-point interface between the Radio Equipment Control (REC) and the Radio Equipment (RE), allowing flexibility in either co-locating the REC and the RE, or a remote location of the RE.

Figure 4-29: CPRI Topologies

In most cases, CPRI links are between REC and RE modules or between two RE modules in a chain configuration.



If the destination for the high-speed serial data that leaves the REC is the first RE, it is a single-hop connection. If the serial data from the REC must traverse through multiple REs before reaching the destination RE, it is a multi-hop connection.

Remotely locating the RF transceiver from the main base station introduces a complexity with overall system delay. The CPRI specification requires that the accuracy of measurement of roundtrip delay on single-hop and multi-hop connections be within ± 16.276 ns to properly estimate the cable delay.

For a single-hop system, this allows a variation in roundtrip delay of up to ± 16.276 ns. However, for multi-hop systems, the allowed delay variation is divided among the number of hops in the connection—typically, equal to ± 16.276 ns/(the number of hops) but not always equally divided among the hops.

Deterministic latency on a CPRI link also enables highly accurate triangulation of the location of the caller.

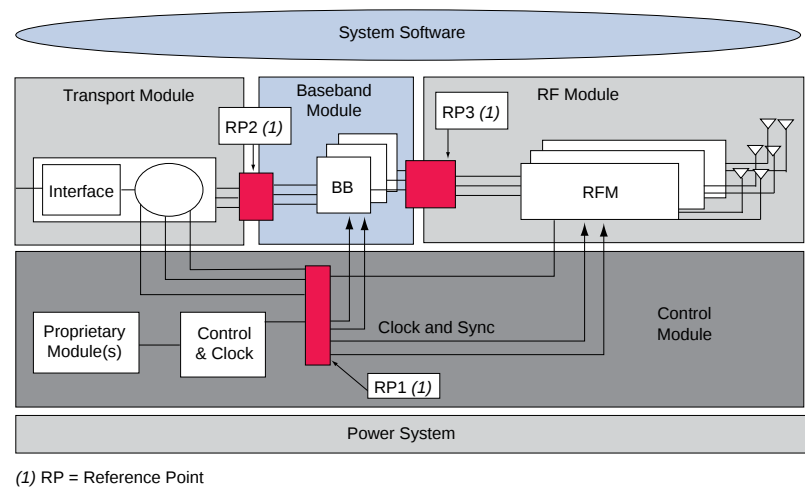
OBSAI was established by several OEMs to develop a set of specifications that can be used for configuring and connecting common modules into base transceiver stations (BTS).

The BTS has four main modules:

- Radio frequency (RF)
- Baseband
- Control
- Transport

In a typical BTS, the radio frequency module (RFM) receives signals using portable devices and converts the signals to digital data. The baseband module processes the encoded signal and brings it back to the baseband before transmitting it to the terrestrial network using the transport module. A control module maintains the coordination between these three functions.

Figure 4-30: Example of the OBSAI BTS Architecture



Using the deterministic latency option, you can implement the CPRI data rates in the following modes:

- Single-width mode—with 8/10-bit channel width
- Double-width mode—with 16/20-bit channel width

Table 4-10: Sample Channel Width Options for Supported Serial Data Rates

Serial Data Rate (Mbps)	Channel Width (FPGA-PCS Fabric)			
	Single Width		Double-Width	
	8-Bit	16-Bit	16-Bit	32-Bit
614.4	Yes	Yes	No	No
1228.8	Yes	Yes	Yes	Yes
2457.6	No	Yes	Yes	Yes
3072	No	Yes	Yes	Yes
4915.2	No	No	No	Yes
6144 ⁽¹³⁾	No	No	No	Yes

6.144-Gbps Support Capability in Cyclone V GT Devices

Cyclone V GT devices support a 6.144 Gbps data rate for the CPRI protocol only. For CPRI 6.144-Gbps transmit jitter compliance, Altera recommends you use only up to three full-duplex channels for every two transceiver banks. The transceivers are grouped in banks of three channels. For transceiver bank information, refer to the *Transceiver Architecture in Cyclone V Devices* chapter.

The maximum number of CPRI channels allowed for 9-channel and 12-channel devices is as follows. The same limitation applies to devices with fewer transceiver channels.

⁽¹³⁾ 6144 Mbps is supported only for the CPRI protocol in the C5 and I5 speed grades.

- For a 9-channel device, you can implement a maximum of 4 full duplex 6.144-Gbps CPRI-compliant channels.
- For a 12-channel device, you can implement a maximum of 6 full duplex 6.144-Gbps CPRI-compliant channels.

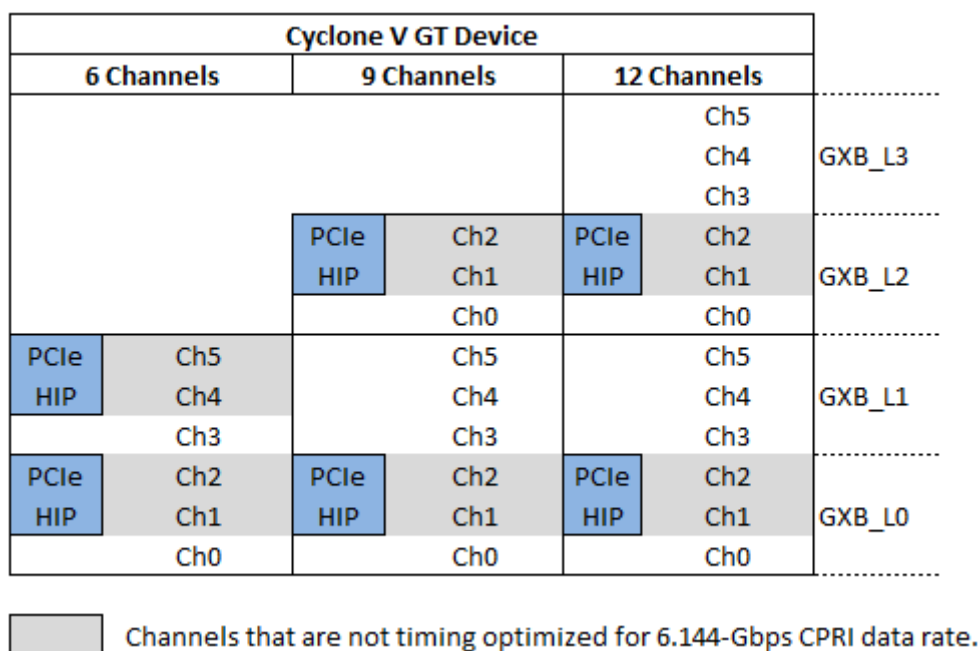
You must increase the voltage on VCCE_GXB and VCCL_GXB to 1.2 V to support the maximum number of channels.

The reference clock frequency for the 6.144 Gbps CPRI channel must be ≥ 307.2 MHz.

The maximum number of transceiver channels in a Cyclone V GT device that can achieve 6.144-Gbps CPRI compliance is based on:

- Transceiver performance in meeting the TX jitter specification for 6.144-Gbps CPRI.
- CPRI channels with an auto-rate negotiation capability from 1228.8 Mbps to 6.144 Gbps.
- 6.144-Gbps CPRI channel restriction based on the following figure.

Figure 4-31: 6.144-Gbps CPRI Channel Placement Restriction



The channels next to a PCIe Hard IP block are not timing optimized for the 6.144-Gbps CPRI data rate. Affected channels are shaded in gray in the above figure. Avoid placing the 6.144-Gbps CPRI channels in the affected channels. The affected channels can still be used as a CMU for the CPRI channels.

Related Information

[Transceiver Architecture in Cyclone V Devices](#)

CPRI Enhancements

The deterministic latency state machine in the word aligner reduces the known delay variation from the word alignment process and automatically synchronizes and aligns the word boundary by slipping a clock cycle in the deserializer. Incoming data to the word aligner is aligned to the boundary of the word alignment

pattern (K28.5). User logic is not required to manipulate the TX bit slipper for constant round-trip delay. In manual mode, the TX bit slipper is able to compensate one unit interval (UI).

The word alignment pattern (K28.5) position varies in byte deserialized data. Delay variation is up to ½ parallel clock cycle. You must add in extra user logic to manually check the K28.5 position in byte deserialized data for the actual latency.

Figure 4-32: Deterministic Latency State Machine in the Word Aligner

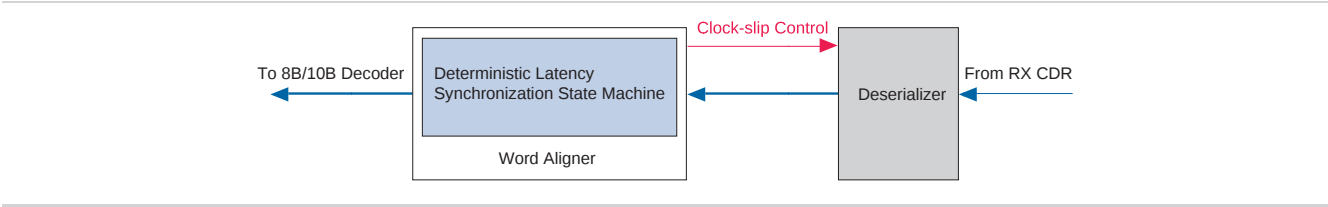


Table 4-11: Methods to Achieve Deterministic Latency Mode in Cyclone V Devices

Existing Feature		Enhanced Feature ⁽¹⁴⁾	
Description	Requirement	Description	Requirement
Manual alignment with bit position indicator provides deterministic latency. Delay variation up to 1 parallel clock cycle	Extra user logic to manipulate the TX bit slipper with a bit position indicator from the word aligner for constant total round-trip delay	Deterministic latency state machine alignment reduces the known delay variation in word alignment operation	None

Related Information

Refer to the "Deterministic Latency PHY IP Core" chapter in the Altera Transceiver PHY IP Core User Guide

⁽¹⁴⁾ Enhanced deterministic latency feature in Cyclone V devices.

Document Revision History

Table 4-12: Document Revision History

Date	Version	Changes
October 2013	2013.10.17	<ul style="list-style-type: none"> Added clock frequency information to "6.144-Gbps Support Capability in Cyclone V GT Devices" section. Removed fPLL information from the "Transceiver Clocking and Channel Placement Guidelines in XAUI Configuration" section. Added Gen2 information to the "Hard IP Configurations for PCIe Gen1 and Gen2" table.
May 2013	2013.05.06	<ul style="list-style-type: none"> Added link to the known document issues in the Knowledge Base. Removed the "Receiver Electrical Idle Inference" section. Added the "Recommended Channel Placement for PCIe Gen2" table. Updated the figures in the "PCIe Supported Configurations and Placement Guidelines" section. Added the "Transceiver Clocking Guidelines for Soft PCS Implementation" section. Added the "6-Gbps Support Capability in Cyclone V GT Devices" section.
November 2012	2012.11.19	<ul style="list-style-type: none"> Reorganized content and updated template. Added the "XAUI" section. Added the "PCI Express" section.

Date	Version	Changes
June 2012	1.1	<ul style="list-style-type: none">• Updated for the Quartus II software version 12.0 release.• Updated Table 4–1.• Updated Figure 4–2.• Updated Figure 4–18.• Added the “Gigabit Ethernet” section.• Added the “Serial Digital Interface” section.• Added the “Serial Data Converter (SDC) JESD204” section.• Added the “SATA and SAS Protocols” section.
October 2011	1.0	Initial release.

Transceiver Custom Configurations in Cyclone V Devices

5

2013.05.06

CV-53005

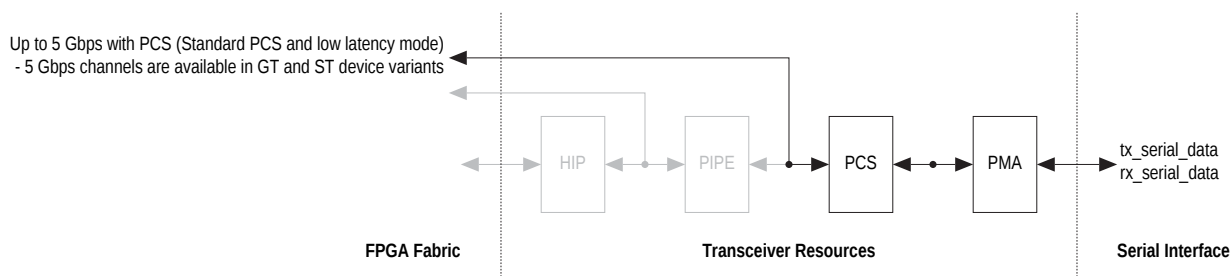
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For integration with the FPGA fabric, the full-duplex transceiver channel supports custom configuration with physical medium attachment (PMA) and physical coding sublayer (PCS).

You can customize the transceiver with one of the following configurations:

- Standard PCS— Physical coding sublayer (PCS) and physical medium attachment (PMA)
- Standard PCS in low latency mode— Low latency PCS and PMA

Figure 5-1: Custom Configuration Options



Related Information

[Cyclone V Device Handbook: Known Issues](#)

Lists the planned updates to the *Cyclone V Device Handbook* chapters.

Standard PCS Configuration

In this configuration, you can customize the transceiver channel to include a PMA and PCS with functions that your application requires. The transceiver channel interfaces with the FPGA fabric through the PCS.

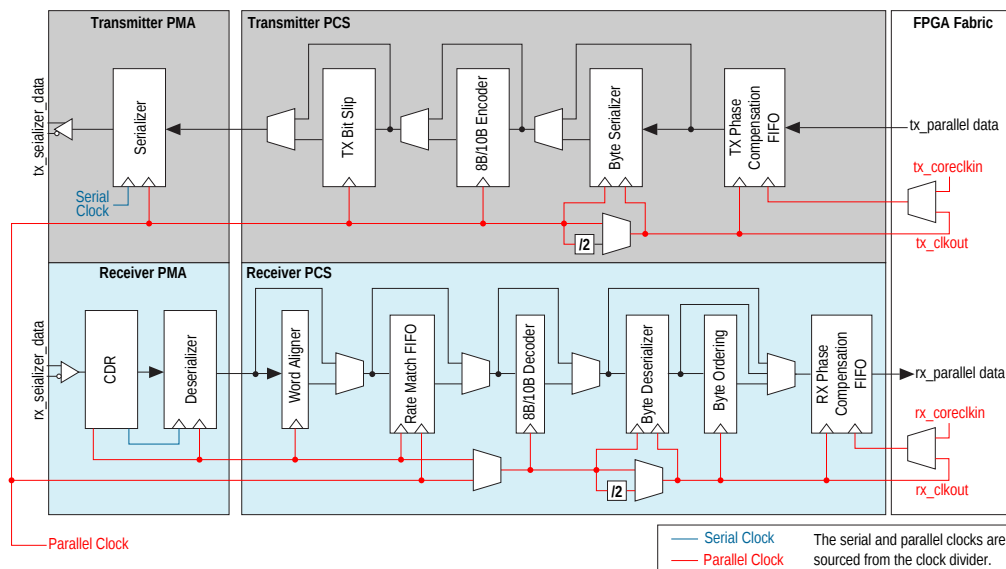
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Figure 5-2: Complete Datapath in a Custom Configuration

Based on your application requirements, you can enable, modify, or disable the blocks, except the deskew FIFO block, as shown in the following figure.



Custom Configuration Channel Options

There are multiple channel options when you use Custom Configuration.

The supported interface width varies depending on the usage of the byte serializer/deserializer (SERDES), and the 8B/10B encoder or decoder. The byte serializer or deserializer is assumed to be enabled. Otherwise, the maximum data rate supported is half of the specified value.

The maximum supported data rate varies depending on the customization.

Table 5-1: Maximum Supported Data Rate

The following table shows the maximum supported data rate for the fastest speed grade in Standard PCS (transceiver speed grade 6) for Cyclone V GX and SX devices, and (transceiver speed grade 5) for Cyclone V GT and ST devices.

Data Configuration	PMA-PCS Interface Width	PCS-FPGA Fabric Interface Width		Maximum Data Rate for GX and SX (Mbps)	Maximum Data Rate for GT and ST (Mbps)
		8B/10B Enabled	8B/10B Disabled		
Single-width	8	—	8	1,500	1,500
			16	3,000	3,000
	10	8	10	1,875	1,875
		16	20	3,125	3,750

Data Configuration	PMA-PCS Interface Width	PCS-FPGA Fabric Interface Width		Maximum Data Rate for GX and SX (Mbps)	Maximum Data Rate for GT and ST (Mbps)
		8B/10B Enabled	8B/10B Disabled		
Double-width	16	—	16	2,621.44	2,621.44
			32	3,125	5,000
	20	16	20	3,125	3,276.8
		32	40	3,125	5,000

In all the supported configuration options of the channel, the transmitter bit-slip function is optional, where:

- The blocks shown as “Disabled” are not used but incur latency.
- The blocks shown as “Bypassed” are not used and do not incur any latency.
- The transmitter bit-slip is disabled.

Figure 5-3: Configuration Options for Custom Single-Width Mode (8-bit PMA–PCS Interface Width)

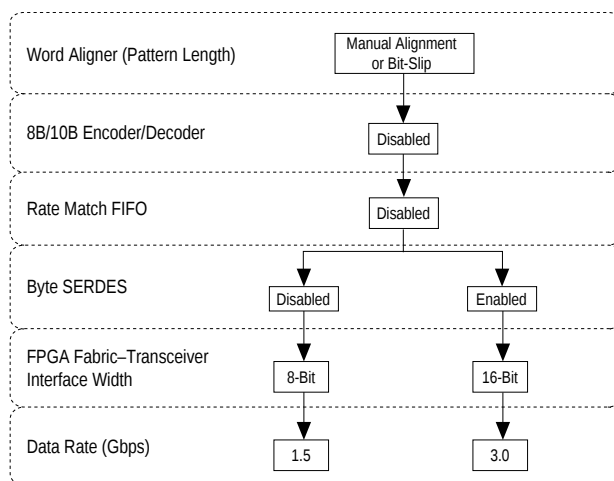


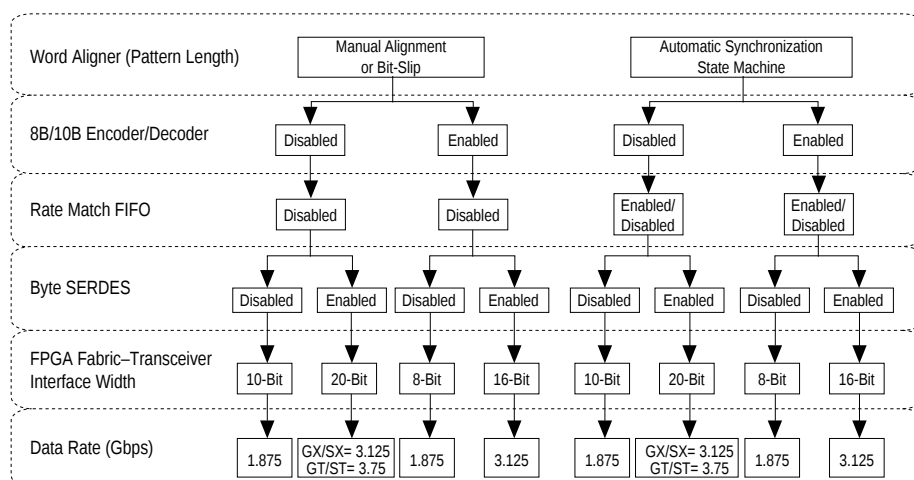
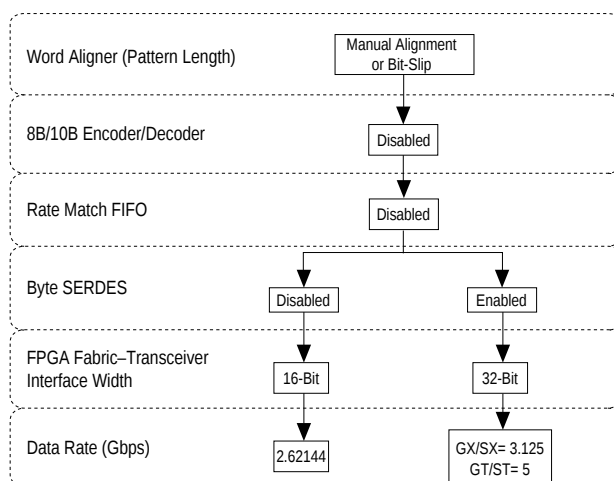
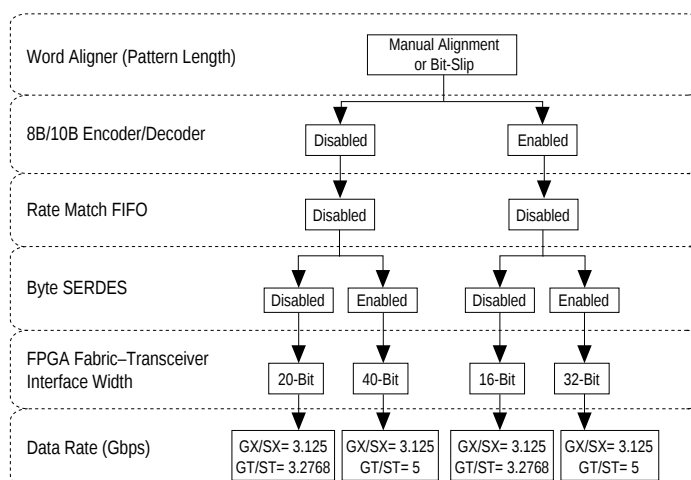
Figure 5-4: Configuration Options for Custom Single-Width Mode (10-bit PMA–PCS Interface Width)**Figure 5-5: Configuration Options for Custom Double-Width Mode (16-bit PMA–PCS Interface Width)**

Figure 5-6: Configuration Options for Custom Double-Width Mode (20-bit PMA–PCS Interface Width)

Rate Match FIFO in Custom Configuration

In a custom configuration, the 20-bit pattern for the rate match FIFO is user-defined. The FIFO operates by looking for the 10-bit control pattern followed by the 10-bit skip pattern in the data, after the word aligner restores the word boundary. After finding the pattern, the FIFO performs a skip pattern insertion or deletion to ensure that the FIFO does not underflow or overflow a given parts per million (ppm) difference between the clocks.

The rate match FIFO operation requires 8B/10B-coded data.

Rate Match FIFO Behaviors in Custom Single-Width Mode

The different operations available in custom single-width mode for the rate match FIFO are symbol insertion, symbol deletion, full condition, and empty condition.

Table 5-2: Rate Match FIFO Behaviors in Custom Single-Width Mode (10-bit PMA–PCS Interface Width)

Operation	Behavior
Symbol Insertion	Inserts a maximum of four skip patterns in a cluster, only if there are no more than five skip patterns in the cluster after the symbol insertion.
Symbol Deletion	Deletes a maximum of four skip patterns in a cluster, only if there is one skip pattern left in the cluster after the symbol deletion.
Full Condition	Deletes the data byte that causes the FIFO to go full.
Empty Condition	Inserts a /K30.7/ (9'h1FE) after the data byte that caused the FIFO to go empty.

Rate Match FIFO Behaviors in Custom Double-Width Mode

The different operations available in custom double-width mode for the rate match FIFO are symbol insertion, symbol deletion, full condition, and empty condition.

Table 5-3: Rate Match FIFO Behaviors in Custom Double-Width Mode (20-bit PMA–PCS Interface Width)

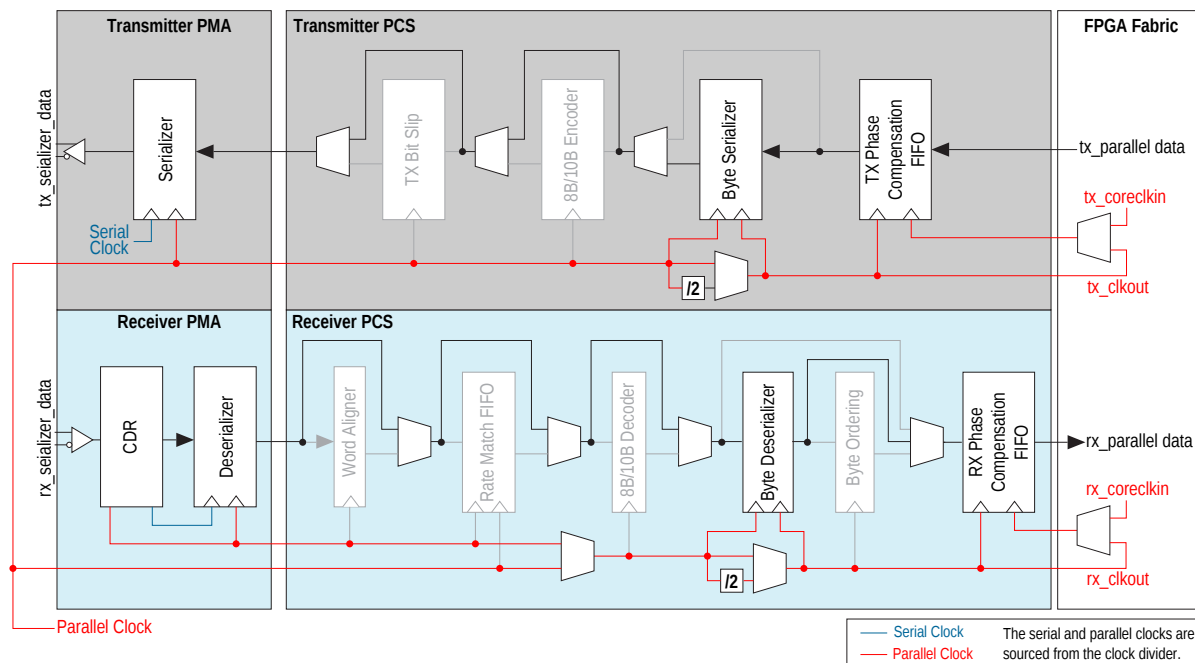
Operation	Behavior
Symbol Insertion	Inserts as many pairs (10-bit skip patterns at the LSByte and MSByte of the 20-bit word at the same clock cycle) of skip patterns as needed.
Symbol Deletion	Deletes as many pairs (10-bit skip patterns at the LSByte and MSByte of the 20-bit word at the same clock cycle) of skip patterns as needed.
Full Condition	Deletes the pair (20-bit word) of data bytes that causes the FIFO to go full.
Empty Condition	Inserts a pair of /K30.7/ ({9'h1FE, 9'h1FE}) after the data byte that causes the FIFO to go empty.

Standard PCS in Low Latency Configuration

In this configuration, you can customize the transceiver channel to include a PMA and PCS that bypasses most of the PCS logical functionality for a low latency datapath.

To provide a low latency datapath, the PCS includes only the phase compensation FIFO in phase compensation mode, and optionally, the byte serializer and byte deserializer blocks, as shown in the following figure. The transceiver channel interfaces with the FPGA fabric through the PCS.

Figure 5-7: Datapath in Low Latency Custom Configuration



The maximum supported data rate varies depending on the customization and is identical to the custom configuration except that the 8B/10B block is disabled

Low Latency Custom Configuration Channel Options

There are multiple channel options when you use Low Latency Custom Configuration.

In the following figures:

- The blocks shown as “Disabled” are not used but incur latency.
- The blocks shown as “Bypassed” are not used and do not incur any latency.
- The transmitter bit-slip is disabled.

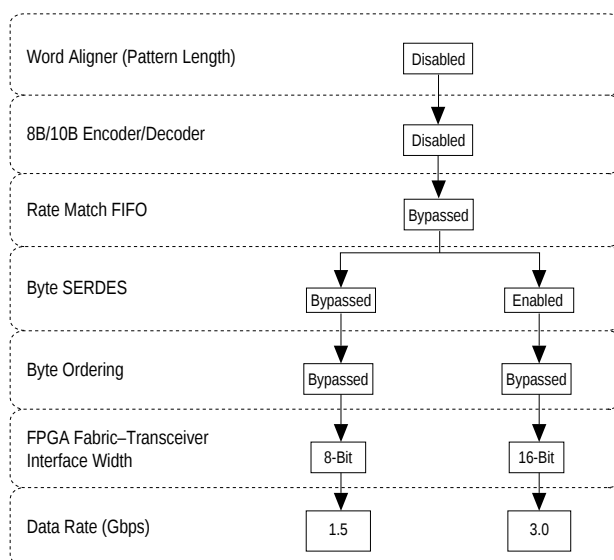
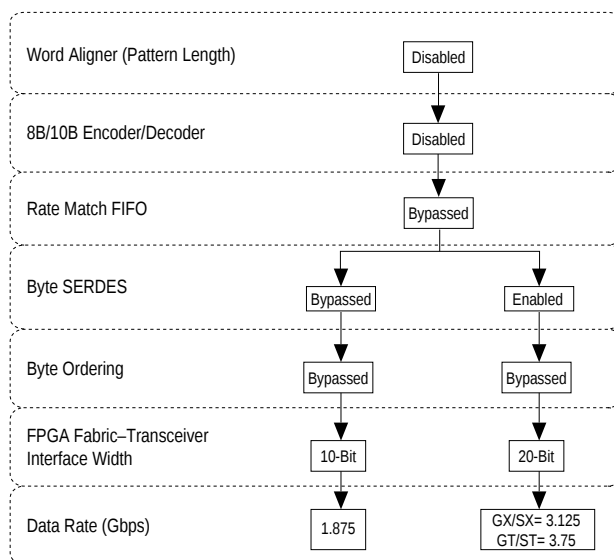
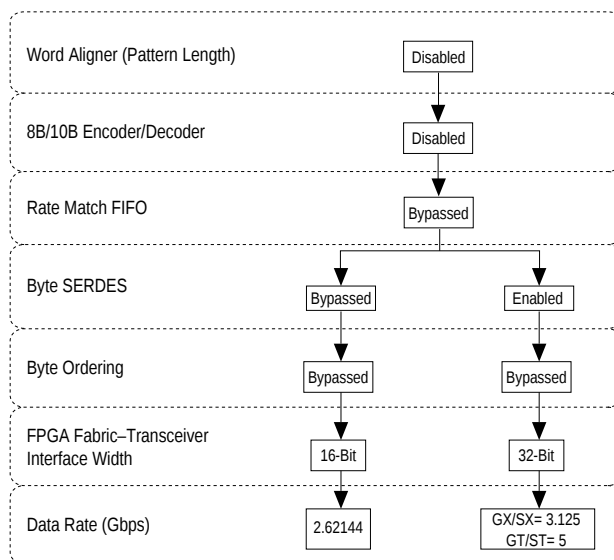
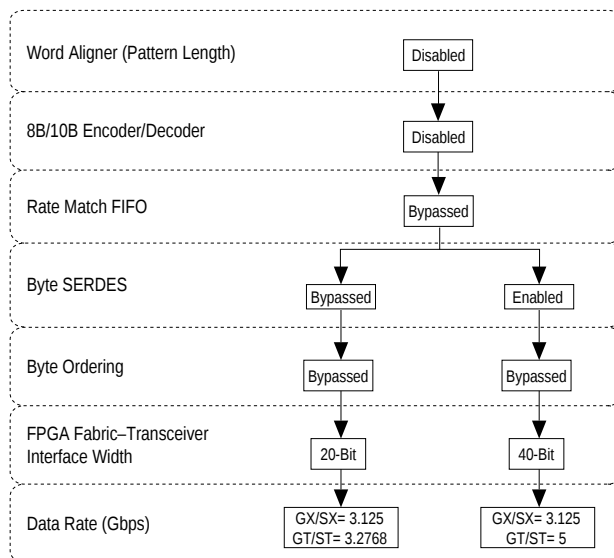
Figure 5-8: Configuration Options for Low Latency Custom Single-Width Mode (8-bit PMA–PCS Interface Width)**Figure 5-9: Configuration Options for Low Latency Custom Single-Width Mode (10-bit PMA–PCS Interface Width)**

Figure 5-10: Configuration Options for Low Latency Custom Double-Width Mode (16-bit PMA–PCS Interface Width)**Figure 5-11: Configuration Options for Low Latency Custom Double-Width Mode (20-bit PMA–PCS Interface Width)**

Document Revision History

Table 5-4: Document Revision History

Date	Version	Changes
May 2013	2013.05.06	Added link to the known document issues in the Knowledge Base.
November 2012	2012.11.19	Reorganized content and updated template.
June 2012	1.1	Updated for the Quartus II software version 12.0 release.
October 2011	1.0	Initial release.

2013.05.06

CV-53006

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The Cyclone V loopback options allow you to verify how different functional blocks work in the transceiver.

Related Information

[Cyclone V Device Handbook: Known Issues](#)

Lists the planned updates to the Cyclone V Device Handbook chapters.

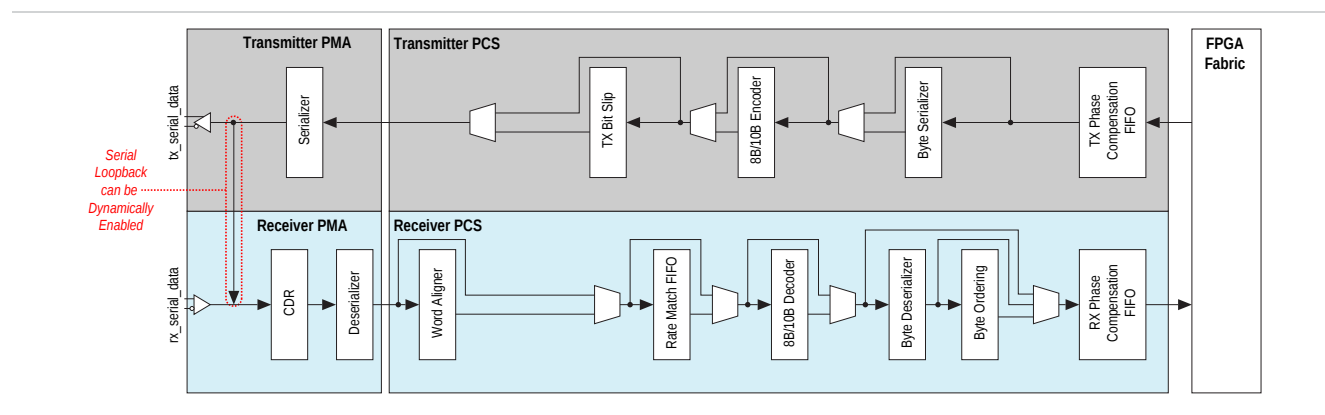
Serial Loopback

This section describes the use of serial loopback as a debugging aid to ensure the enabled PCS and PMA blocks in the transmitter and receiver channels function correctly.

Serial loopback is available for all transceiver configurations except the PIPE mode. You can use serial loopback as a debugging aid to ensure that the enabled physical coding sublayer (PCS) and physical media attachment (PMA) blocks in the transmitter and receiver channels are functioning correctly. Furthermore, you can dynamically enable serial loopback on a channel-by-channel basis.

The data from the FPGA fabric passes through the transmitter channel and is looped back to the receiver channel, bypassing the receiver buffer. The received data is available to the FPGA logic for verification.

Figure 6-1: Serial Loopback Datapath



When you enable serial loopback, the transmitter channel sends data to both the `tx_serial_data` output port and to the receiver channel. The differential output voltage on the `tx_serial_data` port is based on the selected differential output voltage (V_{OD}) settings.

The looped-back data is forwarded to the receiver clock data recovery (CDR). You must provide an alignment pattern for the word aligner to enable the receiver channel to retrieve the byte boundary.

If the device is not in the serial loopback configuration and is receiving data from a remote device, the recovered clock from the receiver CDR is locked to the data from the remote source.

Note: For the `phy_serial_loopback` register access description and addressing, refer to the “Loopback Modes” section of the *Transceiver Reconfiguration Controller* chapter in the *Altera Transceiver PHY IP Core User Guide*.

If the device is placed in the serial loopback configuration, the data source to the receiver changes from the remote device to the local transmitter channel—prompting the receiver CDR to start tracking the phase of the new data source. During this time, the recovered clock from the receiver CDR may be unstable. Because the receiver PCS is running off of this recovered clock, you must place the receiver PCS under reset by asserting the `rx_digitalreset` signal during this period.

Note: When moving into or out of serial loopback, you must assert the `rx_digitalreset` signal for a minimum of two parallel clock cycles.

Related Information

[Altera Transceiver PHY IP Core User Guide](#)

Forward Parallel Loopback

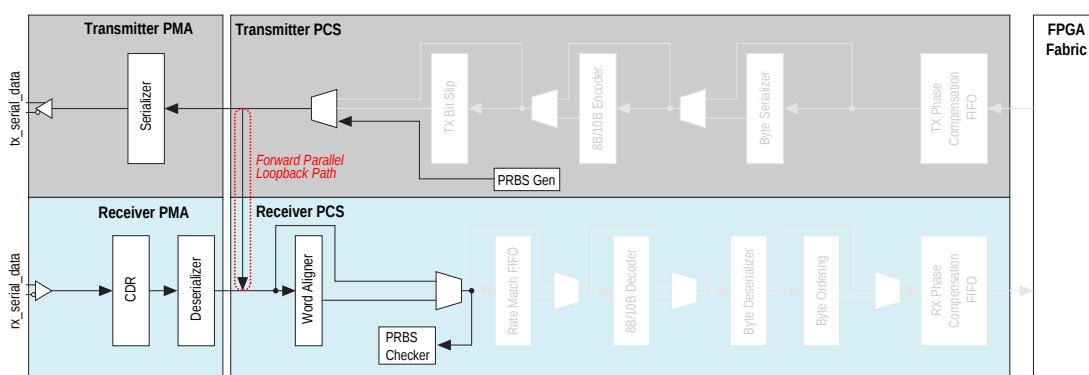
Forward parallel loopback is a debugging aid to ensure the enabled PCS blocks in the transmitter and receiver channel function correctly.

Forward parallel loopback is only available in transceiver Native PHY. You enable forward parallel loopback by enabling the PRBS test mode, through the dynamic reconfiguration controller. You must perform a `rx_digitalreset` after the dynamic reconfiguration operation has completed.

Parallel data travels across the forward parallel loopback path, passing through the RX word aligner, and finally verified inside the RX PCS PRBS verifier block. Check the operations status from the FPGA fabric.

Figure 6-2: Parallel Loopback Datapath

The following figure shows the parallel PRBS data generated by the TX PCS PRBS generator block.



Note: Usage details for the feature are described in the *Altera Transceiver PHY IP Core User Guide*.

Related Information

[Altera Transceiver PHY IP Core User Guide](#)

PIPE Reverse Parallel Loopback

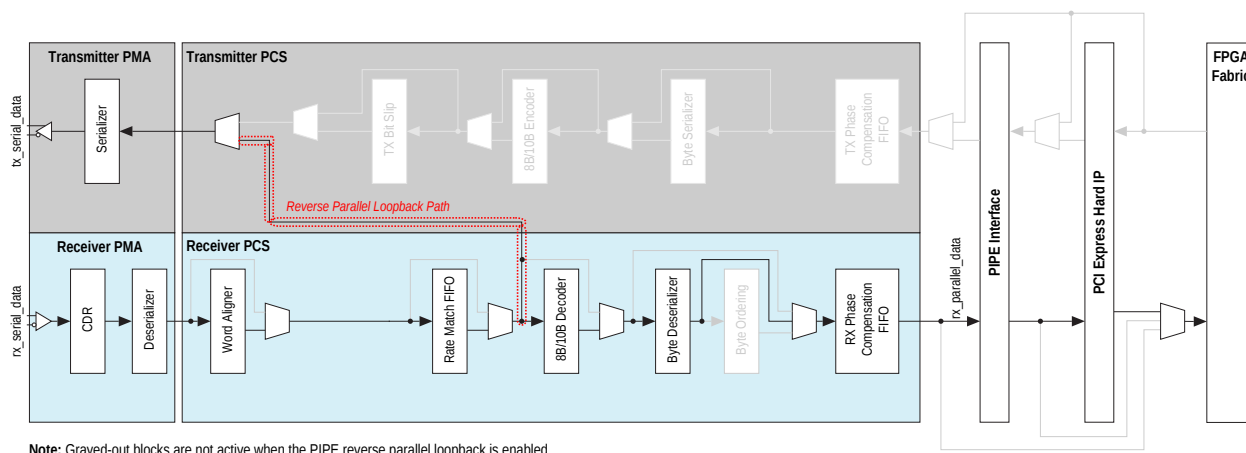
This section describes PIPE Reverse Parallel Loopback debugging option using parallel data through the rate match FIFO, transmitter serializer, and `tx_serial_data` port path.

PIPE reverse parallel loopback is only available in the PCIe® configuration for Gen1 and Gen2 data rates. Figure 2 shows the received serial data passing through the receiver CDR, deserializer, word aligner, and rate match FIFO buffer. The parallel data from the rate match FIFO is then looped back to the transmitter serializer and transmitted out through the `tx_serial_data` port. The received data is also available to the FPGA fabric through the `rx_parallel_data` signal.

PIPE reverse parallel loopback is compliant with the PCIe 2.0 specification. To enable this loopback configuration, assert the `tx_detectrx_loopback` signal.

Note: PIPE reverse parallel loopback is the only loopback option supported in the PCIe configuration.

Figure 6-3: PIPE Reverse Parallel Loopback Configuration Datapath



Reverse Serial Loopback

You can use the reverse serial loopback option to debug with data through the `rx_serial_data` port, receiver CDR, and `tx_serial_data` port path.

You can enable reverse serial loopback through the reconfiguration controller.

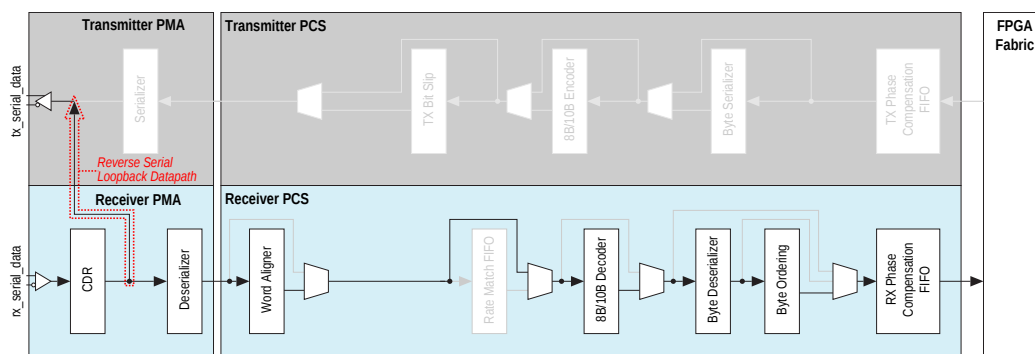
Note: For further details, refer to the Altera Transceiver PHY IP Core User Guide.

In reverse serial loopback, the data is received through the `rx_serial_data` port, re-timed through the receiver CDR, and sent to the `tx_serial_data` port. The received data is also available to the FPGA logic. No dynamic pin control is available to select or deselect reverse serial loopback.

The transmitter buffer is the only active block in the transmitter channel. You can change the V_{OD} and the pre-emphasis first post tap values on the transmitter buffer through the dynamic reconfiguration controller.

Reverse serial loopback is often implemented when using a bit error rate tester (BERT) on the upstream transmitter.

Figure 6-4: Reverse Serial Loopback Datapath



Note: Grayed-out blocks are not active when the reverse serial loopback is enabled.

Related Information

[Altera Transceiver PHY IP Core User Guide](#)

Reverse Serial Pre-CDR Loopback

This section describes reverse serial pre-CDR loopback debugging with a data path through the rx_serial_data port to the tx_serial_data port, and before the receiver CDR.

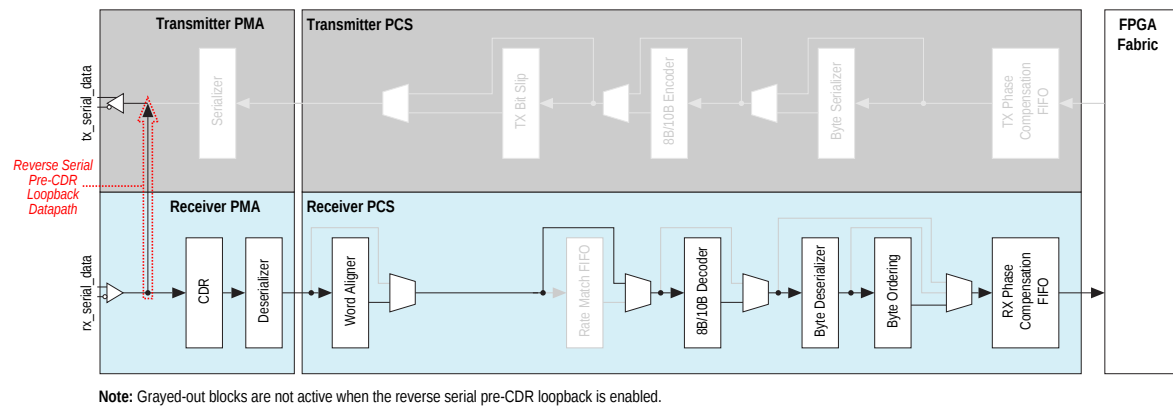
You can enable reverse serial pre-CDR loopback through the reconfiguration controller.

Note: For further details, refer to the Altera Transceiver PHY IP Core User Guide.

In reverse serial pre-CDR loopback, the data received through the rx_serial_data port is looped back to the tx_serial_data port before the receiver CDR. The received data is also available to the FPGA logic. No dynamic pin control is available to select or deselect reverse serial pre-CDR loopback.

The transmitter buffer is the only active block in the transmitter channel. You can change the VOD on the transmitter buffer through the dynamic reconfiguration controller. The pre-emphasis settings for the transmitter buffer cannot be changed in this configuration.

Figure 6-5: Reverse Serial Pre-CDR Loopback Datapath



Related Information
[Altera Transceiver PHY IP Core User Guide](#)

Document Revision History

The table below lists the revision history for this chapter.

Table 6-1: Document Revision History

Date	Version	Changes
May 2013	2013.05.06	<ul style="list-style-type: none">Added the Forward Parallel Loopback topic.Updated the Reverse Serial Loopback topic.Updated the Reverse Serial Pre-CDR Loopback topic.Added link to the known document issues in the Knowledge Base.
November 2012	2012.11.19	<ul style="list-style-type: none">Reorganized content and updated template.Minor updates for the Quartus II software version 12.1.
June 2012	1.0	Initial release.

2013.05.06

CV-53007



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The transceiver reconfiguration controller offers several different dynamic reconfiguration modes. You can choose the appropriate reconfiguration mode that best suits your application needs. All the dynamic reconfiguration modes are implemented through the transceiver Reconfiguration Controller PHY IP.

Related Information

[Cyclone V Device Handbook: Known Issues](#)

Lists the planned updates to the *Cyclone V Device Handbook* chapters.

Dynamic Reconfiguration Features

The following table lists the available dynamic reconfiguration features.

Table 7-1: Reconfiguration Features

Reconfiguration Feature	Description	Affected Blocks
Offset Cancellation	Counter offset variations due to process operation for the analog circuit. This feature is mandatory if you use receivers.	CDR
DCD Calibration	Compensates for the duty cycle distortion caused by clock network skew.	TX buffer and clock network skew
Analog Controls Reconfiguration	Fine-tune signal integrity by adjusting the transmitter (TX) and receiver (RX) analog settings while bringing up a link.	Analog circuit of TX and RX buffer
Loopback Modes	Enable or disable Pre- and Post-CDR Reverse Serial Loopback dynamically.	PMA

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Reconfiguration Feature	Description	Affected Blocks
Data Rate Change	Increase or decrease the data rate (/1, /2, /4, /8) for autonegotiation purposes such as CPRI and SATA/SAS applications	TX Local clock dividers
	Reconfigure the TX PLL settings for protocols with multi-data rate support such as CPRI	TX PLL
	Switch between multiple TX PLLs for multi-data rate support	<ul style="list-style-type: none"> TX PLL Fractional PLL (Reconfigure the fPLL data rate with the ALTERA_PLL_RECONFIG megafunction.)
	Channel reconfiguration—Reconfigure the RX CDR from one data rate to another data rate	CDR

Related Information

- [Backplane Applications with 28 nm FPGAs](#)
- [AN661: Implementing Fractional PLL Reconfiguration with ALTERA_PLL and ALTERA_PLL_RECONFIG Megafunctions](#)

For information about reconfiguration of the fPLL data rate.

Offset Cancellation

Offset cancellation adjusts the offsets within the CDR parameters for process variations.

Every transceiver channel has offset cancellation circuitry to compensate for the offset variations that are caused by process operations. The offset cancellation circuitry is controlled by the offset cancellation control logic IP within the Transceiver Reconfiguration Controller. Resetting the Transceiver Reconfiguration Controller during user mode does not trigger the offset cancellation process.

When offset cancellation calibration is complete, the `reconfig_busy` status signal is deasserted to indicate the completion of the process.

The clock (`mgmt_clk_clk`) used by the Transceiver Reconfiguration Controller is also used for transceiver calibration and must be 75-125 MHz if the Hard IP for PCIe Express IP core is not enabled. When the Hard IP for PCIe Express is enabled, the frequency range is 75-100 MHz. If the clock (`mgmt_clk_clk`) is not free-running, hold the reconfiguration controller reset (`mgmt_rst_reset`) until the clock is stable.

Transmitter Duty Cycle Distortion Calibration

The duty cycle calibration function tunes the transmitter to minimize duty cycle distortion.

The transmitter clocks generated by the CMU that travel across the clock network may introduce duty cycle distortions (DCD). Reduce DCD with the DCD calibration IP that is integrated in the transceiver reconfiguration controller.

Enabled the DCD calibration IP in Cyclone GT devices for better TX jitter performance, if either of the following conditions are met:

- Data rate is ≥ 4915.2 Mbps
- Clock network switching (TX PLL switching) and the data rate is ≥ 4915.2 Mbps

The following DCD calibration modes are supported:

- DCD calibration at power-up mode
- Manual DCD calibration during user mode

DCD calibration is performed automatically after device configuration and before entering user mode if the transceiver channels connected have the **Calibrate duty cycle during power up** option enabled. You can optionally trigger DCD calibration manually during user mode if:

- You reconfigure the transceiver from lower data rates to higher data rates (≥ 4.9152 Gbps)
- You perform clock network switching (TX PLL switching) and switch to data rates of ≥ 4915.2 Mbps

You do not have to enable DCD calibration if the transceivers are operating below 4.9152 Gbps.

When DCD calibration and offset cancellation are enabled, the `reconfig_busy` status signal from the reconfiguration controller is deasserted to indicate the completion of both processes. If DCD calibration is not enabled, the deassertion of `reconfig_busy` signal indicates the completion of the offset cancellation process.

Related Information

- [AN 676: Using the Transceiver Reconfiguration Controller for Dynamic Reconfiguration in Arria V and Cyclone V Devices](#)
- [Altera Transceiver PHY IP Core User Guide](#)

PMA Analog Controls Reconfiguration

You can dynamically reconfigure the analog controls setting after offset cancellation is complete and the reset sequence is performed. You can continue with the subsequent reconfigurations of the analog controls when the `reconfig_busy` status signal is low. A high on the `reconfig_busy` signal indicates that the reconfiguration operation is in progress.

You can reconfigure the following transceiver analog controls:

- Transmitter pre-emphasis
- Differential output voltage (V_{OD})
- Receiver equalizer control
- Direct-current (DC) gain settings

To reconfigure the analog control settings, perform read and write operations to the PMA analog settings reconfiguration control IP within the reconfiguration controller.

Related Information

[Altera Transceiver PHY IP Core User Guide](#)

For information about the read and write operations with the reconfiguration controller

Dynamic Reconfiguration of Loopback Modes

You can enable the pre- and post-CDR reverse serial loopback modes by writing the appropriate bits of the Transceiver Reconfiguration Controller

The following loopback paths are available:

- **Post-CDR reverse serial loopback path**— The RX captures the input data and feeds it into the CDR. The recovered data from the CDR output feeds into the TX driver and sends to the TX pins through the TX driver. For this path, the RX and CDR can be tested. For this path, the TX driver can be programmed to use either the main tap only or the main tap and the pre-emphasis first post-tap. Enabling or disabling the post-CDR reverse serial loopback modes is done through the PMA Analog Reconfiguration IP in the Transceiver Reconfiguration PHY IP.
- **Pre-CDR reverse serial loopback path**— The RX captures the input data and feeds it back to the TX driver through a buffer. With this path, you can perform a quick check for the quality of the RX and TX buffers. Enabling or disabling the pre-CDR reverse serial loopback mode.

Note: Serial loopback can be implemented with the transceiver PHY IP directly using the Avalon interface or a control port.

Related Information

- [Transceiver Reconfiguration Controller chapter of the Altera Transceiver PHY IP Core User Guide](#)
- [Transceiver Loopback Support in Cyclone V Devices](#)

Transceiver PLL Reconfiguration

You can use the PLL reconfiguration registers to switch the reference clock input to the TX PLL or the clock data recovery (CDR) circuitry.

For example, you can switch the reference clock from 100 MHz to 125 MHz. You can also change the data rate from 2.5 Gbps to 5 Gbps by reconfiguring the transmitter PLL connected to the transceiver channel.

Note: Reference clock switching is only supported on the dedicated REFCLK pin.

The Transceiver Reconfiguration PHY IP provides an Avalon[®]-MM user interface to perform PLL reconfiguration.

Related Information

["PLL Reconfiguration" section in the Transceiver Reconfiguration Controller chapter of the Altera Transceiver PHY IP Core User Guide](#)

For information about performing PLL reconfiguration.

Transceiver Channel Reconfiguration

You can use channel reconfiguration to dynamically reconfigure the channel in a transceiver PHY IP core. Among the settings that you can change dynamically are the data rate and interface width.

You can reconfigure the channels in the following ways:

- Reconfigure the CDR of the receiver channel.
- Enable and disable all static PCS sub-blocks.
- Select an alternate PLL within the transceiver block to supply a different clock to the transceiver clock generation block.
- Reconfigure the TX local clock divider with a 1, 2, 4, or 8 division factor.

Every transmitter channel has a clock divider. When you reconfigure these clock dividers, ensure that the functional mode of the transceiver channel supports the reconfigured data rate.

Transceiver Interface Reconfiguration

You can reconfigure the transceiver interfaces by reconfiguring the FPGA fabric transceiver channel data width that includes PCS-PLD and PMA-PCS interfaces.

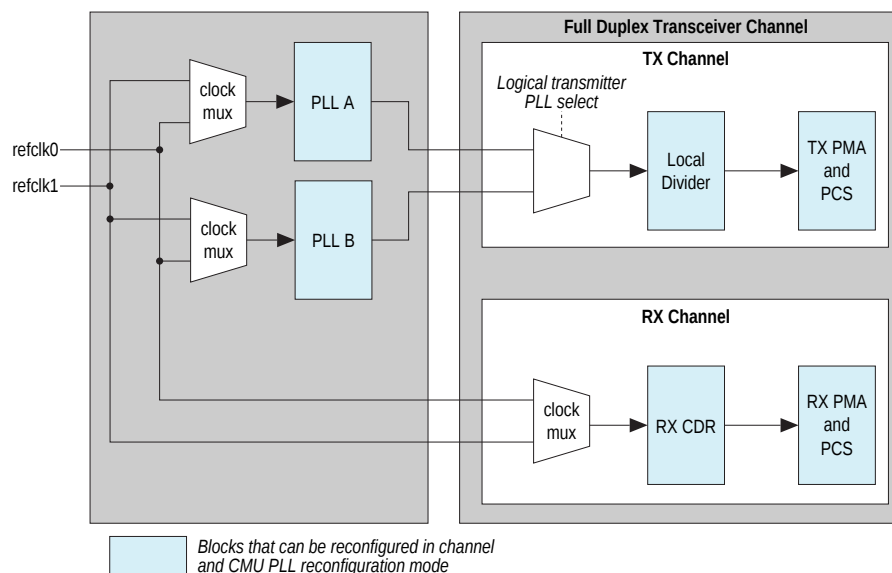
For example, you can reconfigure the custom PHY IP to enable or disable the 8B/10B encoder/decoder. There is no limit to the number of functional modes you can reconfigure the transceiver channel to if the various clocks involved support the transition. When you switch the custom PHY IP from one function mode to a different function mode, you may need to reconfigure the FPGA fabric-transceiver channel data width, enable or disable PCS sub-blocks, or both, to comply with the protocol requirements.

Channel reconfiguration only affects the channel involved in the reconfiguration (the transceiver channel specified by the unique logical channel address), without affecting the remaining transceiver channels controlled by the same Transceiver Reconfiguration Controller. PLL reconfiguration affects all channels that are currently using that PLL for transmission.

Channel reconfiguration from either a transmitter-only configuration to a receiver-only configuration or vice versa is not allowed.

Figure 7-1: Transceiver Channel and PLL Reconfiguration in a Transceiver Block

The following figure shows the functional blocks you dynamically reconfigure using transceiver channel and PLL reconfiguration mode.

**Related Information**

“Channel and PLL Reconfiguration” section in the *Transceiver Reconfiguration Controller* chapter of the *Altera Transceiver PHY IP Core User Guide*

For information about transceiver channel and PLL reconfiguration.

Reduced .mif Reconfiguration

Reduce reconfiguration time by reconfiguring only the affected blocks in the transceiver channels.

This reconfiguration mode affects only the modified settings of the channel to reduce reconfiguration time significantly. For example, in SATA/SAS applications, auto-rate negotiation must be completed within a short period of time to meet the protocol specification. The reduced .mif method helps to reconfigure the channel to meet these specifications. You can generate the reduced .mif files manually or by using the `xcvr_diffmifgen.exe` utility.

Related Information

Altera Transceiver PHY IP Core User Guide

For information about reduced .mif creation.

Unsupported Reconfiguration Modes

The following reconfiguration modes are not supported:

- Switching between a receiver-only channel and a transmitter-only channel
- Switching between bonded to non-bonded mode or bonded mode with different xN lanes count (for example, switching from bonded x2 to bonded x4)
- Switching between one PHY IP to another PHY IP (for example Deterministic Latency PHY IP to Custom PHY IP)
- TX PLL reconfiguration is not supported if the TX PLL is connected to bonded channels

You can achieve PHY to PHY IP reconfiguration only if you use the Native PHY IP to configure your transceiver. For example, if you use the Native PHY IP to configure the SDI mode and a custom proprietary IP mode (also configured using Native PHY IP), you can reconfigure these two modes within the Native PHY IP. The switching refers to enabling and disabling the PCS sub-blocks for both SDI and the custom proprietary IP mode.

Document Revision History

Date	Version	Changes
May 2013	2013.05.06	<ul style="list-style-type: none">• Updated TX DCD calibration information• Included link AN 661 for fPLL reconfiguration• Added link to the known document issues in the Knowledge Base.
November 2012	2012.11.19	<ul style="list-style-type: none">• Rewritten and reorganized content, and updated template• Added TX DCD• Added Transceiver PLL Reconfiguration• Transceiver Channel Reconfiguration• Listed unsupported features



Cyclone V Device Handbook

Volume 3: Hard Processor System Technical Reference Manual



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The chapters in this document, Cyclone V Device Handbook, were revised on the following dates. Where chapters or groups of chapters are available separately, part numbers are listed.

Chapter 1. Introduction to the Hard Processor System
Revised: *November 2012*
Part Number: *cv_54001-1.3*

Chapter 2. Clock Manager
Revised: *November 2012*
Part Number: *cv_54002-1.2*

Chapter 3. Reset Manager
Revised: *November 2012*
Part Number: *cv_54003-1.2*

Chapter 4. Interconnect
Revised: *November 2012*
Part Number: *cv_54004-1.2*

Chapter 5. HPS-FPGA AXI Bridges
Revised: *November 2012*
Part Number: *cv_54005-1.1*

Chapter 6. Cortex-A9 Microprocessor Unit Subsystem
Revised: *November 2012*
Part Number: *cv_54006-1.2*

Chapter 7. CoreSight Debug and Trace
Revised: *November 2012*
Part Number: *cv_54007-1.2*

Chapter 8. SDRAM Controller Subsystem
Revised: *November 2012*
Part Number: *cv_54008-1.1*

Chapter 9. On-Chip Memory
Revised: *November 2012*
Part Number: *cv_54009-1.1*

Chapter 10. NAND Flash Controller
Revised: *November 2012*
Part Number: *cv_54010-1.2*

Chapter 11. SD/MMC Controller
Revised: *November 2012*
Part Number: *cv_54011-1.1*

Chapter 12. Quad SPI Flash Controller

- Revised: *November 2012*
Part Number: *cv_54012-1.2*
- Chapter 13. FPGA Manager
Revised: *November 2012*
Part Number: *cv_54013-1.3*
- Chapter 14. System Manager
Revised: *November 2012*
Part Number: *cv_54014-1.2*
- Chapter 15. Scan Manager
Revised: *November 2012*
Part Number: *cv_54015-1.2*
- Chapter 16. DMA Controller
Revised: *November 2012*
Part Number: *cv_54016-1.1*
- Chapter 17. Ethernet Media Access Controller
Revised: *November 2012*
Part Number: *cv_54017-1.2*
- Chapter 18. USB 2.0 OTG Controller
Revised: *November 2012*
Part Number: *cv_54018-1.2*
- Chapter 19. SPI Controller
Revised: *November 2012*
Part Number: *cv_54019-1.2*
- Chapter 20. I²C Controller
Revised: *November 2012*
Part Number: *cv_54020-1.2*
- Chapter 21. UART Controller
Revised: *November 2012*
Part Number: *cv_54021-1.2*
- Chapter 22. General-Purpose I/O Interface
Revised: *November 2012*
Part Number: *cv_54022-1.2*
- Chapter 23. Timer
Revised: *November 2012*
Part Number: *cv_54023-1.2*
- Chapter 24. Watchdog Timer
Revised: *November 2012*
Part Number: *cv_54024-1.2*
- Chapter 25. CAN Controller
Revised: *November 2012*
Part Number: *cv_54025-1.2*

Chapter 26. Introduction to the HPS Component
Revised: *June 2012*
Part Number: *cv_54026-1.0*

Chapter 27. Instantiating the HPS Component
Revised: *November 2012*
Part Number: *cv_54027-1.1*

Chapter 28. HPS Component Interfaces
Revised: *November 2012*
Part Number: *cv_54028-1.1*

Chapter 29. Simulating the HPS Component
Revised: *November 2012*
Part Number: *cv_54030-1.1*

Appendix A. Booting and Configuration
Revised: *November 2012*
Part Number: *cv_5400A-1.3*

This section includes the following chapters:

- Chapter 1, Introduction to the Hard Processor System
- Chapter 2, Clock Manager
- Chapter 3, Reset Manager

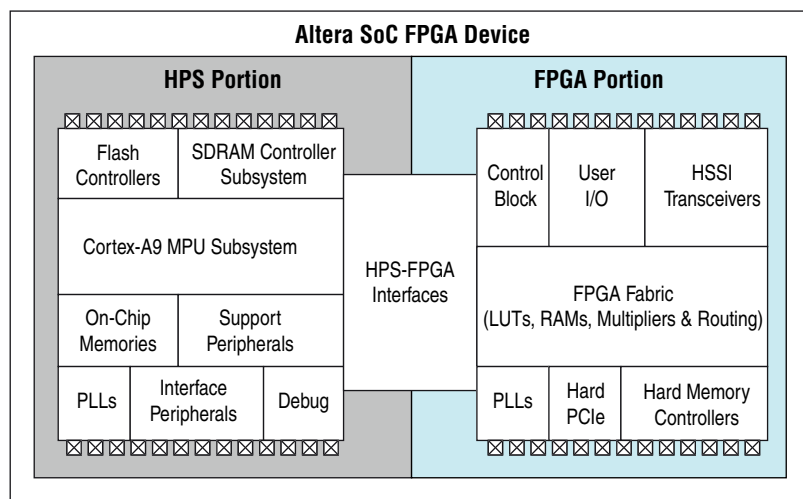


For information about the revision history for chapters in this section, refer to “Document Revision History” in each individual chapter.

The Cyclone® V SoC FPGA device is a single-die system on a chip (SoC) that consists of two distinct parts—a hard processor system (HPS) portion and an FPGA portion.

Figure 1–1 shows a high-level block diagram of the Altera SoC FPGA device. Blocks connected to device pins have symbols (square with X) adjacent to them in the figure.

Figure 1–1. Altera SoC FPGA Device Block Diagram



The HPS contains a microprocessor unit (MPU) subsystem with single or dual ARM® Cortex™-A9 MPCore processors, flash memory controllers, an SDRAM controller subsystem, on-chip memories, support peripherals, interface peripherals, debug capabilities, and PLLs. The dual-processor HPS supports symmetric (SMP) and asymmetric (AMP) multiprocessing.

The FPGA portion of the device contains the FPGA fabric, a control block (CB), phase-locked loops (PLLs), and depending on the device variant, high-speed serial interface (HSSI) transceivers, hard PCI Express® (PCIe®) controllers, and hard memory controllers.



For information about the FPGA portion of the device, refer to [Cyclone V Device Overview](#).

The HPS and FPGA portions of the device are distinctly different. The HPS boots (from any of multiple boot sources, including the FPGA fabric and external flash devices) and the FPGA gets configured (through the HPS or any external source supported by the device).



For more information, refer to the *Booting and Configuration* appendix in volume 3 of the *Cyclone V Device Handbook*.

The HPS and FPGA portions of the device each have their own pins. Pins are not freely shared between the HPS and the FPGA fabric. The HPS I/O pins are configured by software executing in the HPS. Software executing on the HPS accesses control registers in the system manager to assign HPS I/O pins to the available HPS modules. The FPGA I/O pins are configured by an FPGA configuration image through the HPS or any external source supported by the device.

The MPU subsystem can boot from flash devices connected to the HPS pins. Or, when the FPGA portion is configured by an external source, the MPU subsystem can boot from memory available to the FPGA portion of the device.

The HPS and FPGA portions of the device have separate external power supplies and independently power on. You can power on the HPS without powering on the FPGA portion of the device. But to power on the FPGA portion, the HPS must already be on or powered on at the same time as the FPGA portion. You can also turn off the FPGA portion of the device while leaving the HPS power on.

Features of the HPS

The following list contains the main modules of the HPS:

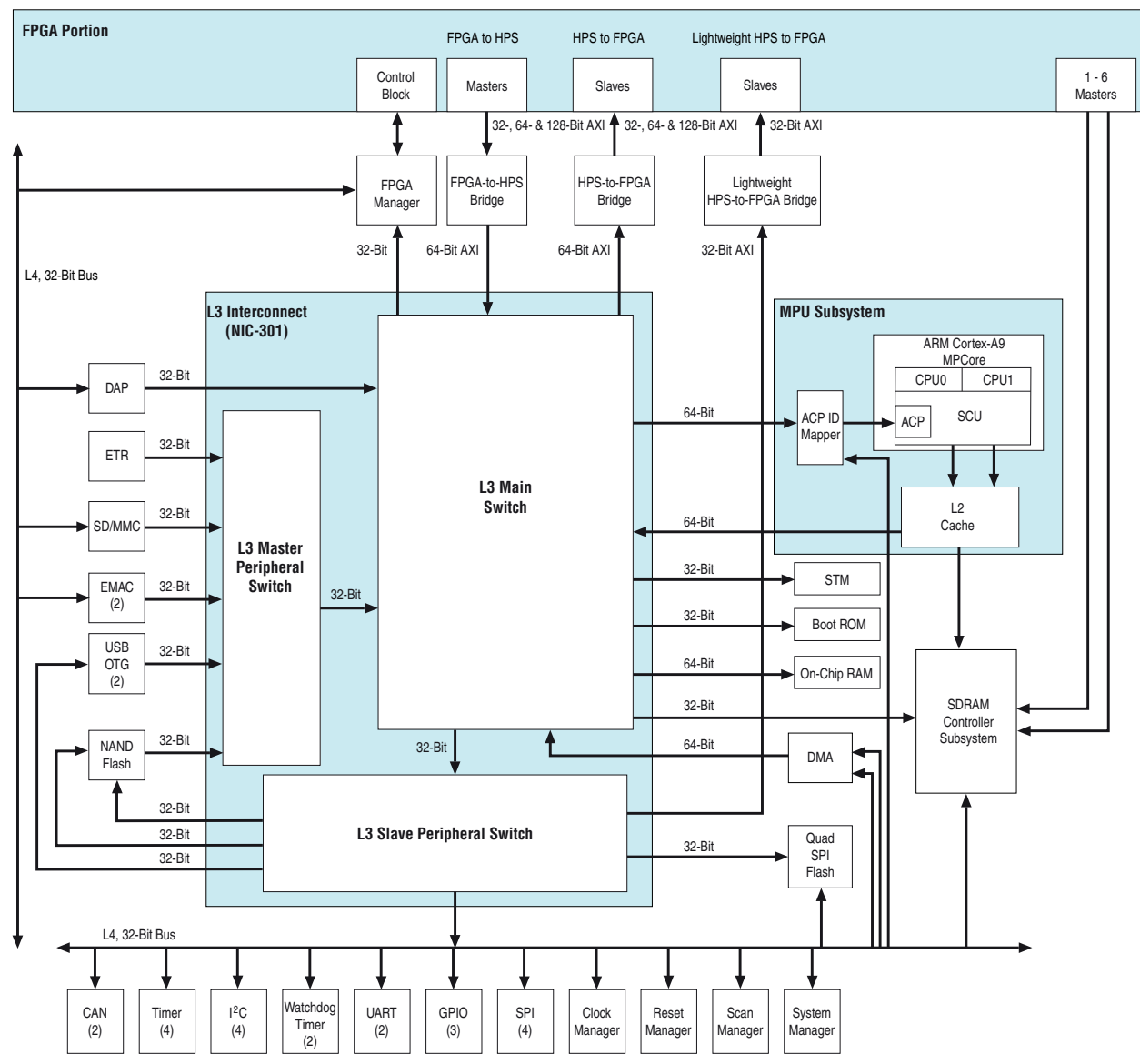
- An MPU subsystem featuring dual ARM Cortex-A9 MPCore processors
- An SDRAM controller subsystem
- One general-purpose direct memory access (DMA) controller
- Two Ethernet media access controllers (EMACs)
- Two USB 2.0 On-The-Go (OTG) controllers
- One NAND flash controller
- One quad SPI flash controller
- One Secure Digital (SD) / MultiMediaCard (MMC) controller
- Two serial peripheral interface (SPI) master controllers
- Two SPI slave controllers
- Four inter-integrated circuit (I²C) controllers
- 64 KB on-chip RAM
- 64 KB on-chip boot ROM
- Two UARTs
- Four timers
- Two watchdog timers

- Three general-purpose I/O (GPIO) interfaces
- Two controller area network (CAN) controllers (certain device variants only)
- ARM CoreSight™ debug components
 - Debug Access Port (DAP)
 - Trace Port Interface Unit (TPIU)
 - System Trace Macrocell (STM)
 - Program Trace Macrocell (PTM)
 - Embedded Trace Router (ETR)
 - Embedded Cross Trigger (ECT)
- A system manager
- A clock manager
- A reset manager
- A scan manager
- An FPGA manager
- One FPGA-to-HPS bridge
- Two HPS-to-FPGA bridges

HPS Block Diagram and System Integration

Figure 1-2 shows a block diagram of most modules in the HPS. Debug modules are not shown.

Figure 1-2. HPS Block Diagram



The following sections list features of the HPS modules and reference related chapters that provide more detailed information. The HPS incorporates third-party intellectual property (IP) from several vendors. Each chapter in this handbook identifies additional third-party IP documentation, if available from the third-party vendors.



No clock information is listed in the following summary sections. For comprehensive clock information for all modules, refer to the *Clock Manager* chapter in volume 3 of the *Cyclone V Device Handbook*.

MPU Subsystem

The MPU subsystem provides the following functionality:

- ARM Cortex-A9 MPCore
 - One or two ARM Cortex-A9 processors in a cluster
 - NEON™ SIMD coprocessor and VFPv3 per processor
 - Snoop Control Unit (SCU) to ensure coherency within the cluster
 - Accelerator coherency port (ACP) that accepts coherency memory access requests.
 - Interrupt controller
 - One general-purpose timer and one watchdog timer per processor
 - Debug and trace features
 - 32-KB instruction and 32-KB data level 1 (L1) caches per processor
 - Memory management unit (MMU) per processor
- ARM L2-310 level 2 (L2) cache
 - Shared 512-KB L2 cache
- ACP ID mapper
 - Maps the 12-bit ID from the level 3 (L3) interconnect to the 3-bit ID supported by the ACP

As shown in [Figure 1–2](#), the L2 cache has one 64-bit master port connected to the L3 interconnect and one 64-bit master port connected directly to the SDRAM controller subsystem. A programmable address filter in the L2 cache controls which portions of the 32-bit physical address space use which master.



For more information, refer to the [Cortex-A9 MPU System](#) chapter in volume 3 of the *Cyclone V Device Handbook*.

Interconnect

The interconnect consists of the L3 interconnect and level 4 (L4) buses. The L3 interconnect is one ARM NIC-301 module composed of the following switches:

- L3 main switch
 - Connects the master, slaves, and other subswitches
 - Provides 64-bit switching capabilities
- L3 master peripheral switch
 - Connects master ports of peripherals with integrated DMA controllers to the L3 main switch
- L3 slave peripheral switch
 - Connects slave ports of peripherals to the L3 main switch

The L4 buses are each connected to a master in the L3 slave peripheral switch. Each L4 bus is 32 bits wide and is connected to multiple slaves. Each L4 bus operates on a separate clock source.



For more information, refer to the *Interconnect* chapter in volume 3 of the *Cyclone V Device Handbook*.

Memory Controllers

The HPS provides the memory controllers described in this section.

SDRAM Controller Subsystem

The SDRAM controller subsystem is mastered by HPS masters and FPGA fabric masters. The FPGA-to-HPS SDRAM interface is compatible with the hard memory controllers in the FPGA portion of the device and with hard SDRAM controllers in non-HPS FPGA devices, such as Stratix IV FPGAs.

The SDRAM controller subsystem implements the following high-level features:

- Support for double data rate 2 (DDR2), DDR3, and low-power double data rate 2 (LPDDR2) devices
- Software-configurable priority scheduling on individual SDRAM bursts
- Error correction code (ECC) support, including calculation, single-bit error correction and write-back, and error counters
- Fully-programmable timing parameter support for all JEDEC-specified timing parameters
- All ports support memory protection and mutual accesses
- Support for ARM Advanced Microcontroller Bus Architecture (AMBA®) Advanced eXtensible Interface (AXI™) quality of service (QoS) for the fabric interfaces

The SDRAM controller subsystem is composed of the SDRAM controller and the DDR PHY.

SDRAM Controller

The SDRAM controller contains a multiport front end (MPFE) that accepts requests from HPS masters and from soft logic in the FPGA fabric via the FPGA-to-HPS SDRAM interface.

The SDRAM controller offers the following features:

- Up to 4 GB address range
- 8-, 16-, and 32-bit data widths
- Optional ECC support
- Low-voltage 1.35V DDR3L and 1.2V DDR3U support
- Full memory device power management support
- Two chip selects

The SDRAM controller provides the following features to maximize memory performance:

- Command reordering (look-ahead bank management)
- Data reordering (out of order transactions)
- Deficit round-robin arbitration with aging for bandwidth management
- High-priority bypass for latency sensitive traffic

DDR PHY

The DDR PHY interfaces the single-port memory controller to the HPS memory I/O.



For more information, refer to the [SDRAM Controller Subsystem](#) chapter in volume 3 of the *Cyclone V Device Handbook*.

NAND Flash Controller

The NAND flash controller is based on the Cadence® Design IP® NAND Flash Memory Controller and offers the following features:

- Supports single-level cell (SLC) and multilevel cell (MLC) NAND flash devices
- Integrated descriptor-based DMA controller
- 8-bit ONFI 1.0 NAND flash devices
- Programmable page sizes of 512 bytes, 2 KB, 4 KB, and 8 KB
- Supports 32, 64, 128, 256, 384, and 512 pages per block
- Programmable hardware ECC for SLC and MLC devices
 - 512 bytes ECC sector size with 4-, 8-, or 16-bit correction
 - 1 KB ECC sector size with 24-bit correction



For more information, refer to the [NAND Flash Controller](#) chapter in volume 3 of the *Cyclone V Device Handbook*.

Quad SPI Flash Controller

The quad SPI flash controller is based on Cadence Quad SPI Flash Controller (QSPI_FLASH_CTRL) and offers the following features:

- Supports SPIx1, SPIx2, or SPIx4 (quad SPI) serial NOR flash devices
- Supports direct access and indirect access modes.
- Supports single I/O, dual I/O, quad I/O instructions
- Programmable data frame size of 8, 16, or 32 bits
- Support up to four chip selects



For more information, refer to the [Quad SPI Controller](#) chapter in volume 3 of the *Cyclone V Device Handbook*.

SD/MMC Controller

The SD/MMC controller is based on Synopsys® DesignWare® Mobile Storage Host (DWC_mobile_storage) controller and offers the following features:

- Integrated descriptor-based DMA
- Supports CE-ATA digital protocol commands
- Supports single card
 - Single data rate (SDR) mode only
 - Programmable card width: x1, x4, or x8
 - Programmable card types: SD, SDIO, or MMC version 4.3 and 4.4 devices
- Up to 64 KB programmable block size



For more information, refer to the *SD/MMC Controller* chapter in volume 3 of the *Cyclone V Device Handbook*.

Support Peripherals

HPS provides the support peripherals described in this section.

Clock Manager

The clock manager offers the following features:

- Manages clocks for HPS
- Supports dynamic clock tuning



For more information, refer to the *Clock Manager* chapter in volume 3 of the *Cyclone V Device Handbook*.

Reset Manager

The reset manager offers the following features:

- Manages reset for HPS



For more information, refer to the *Reset Manager* chapter in volume 3 of the *Cyclone V Device Handbook*.

System Manager

The system manager offers the following features:

- ECC monitoring and control
- Pin multiplexing
- Low-level control of peripheral features not accessible through the control and status registers (CSRs)
- Freeze controller that places I/O elements into a safe state for configuration



For more information, refer to the *System Manager* chapter in volume 3 of the *Cyclone V Device Handbook*.

Scan Manager

The scan manager offers the following features:

- Drives serial scan-chains to FPGA JTAG and HPS I/O bank configuration



For more information, refer to the *Scan Manager* chapter in volume 3 of the *Cyclone V Device Handbook*.

Timers

The four timers are based on the Synopsys DesignWare APB Timers (DW_apb_timers) peripheral and offer the following features:

- 32-bit timer resolution
- Support free-running timer mode
- Programmable time-out period up to approximately 86 seconds (assuming a 50 MHz clock)
- Interrupt generation



For more information, refer to the *Timer* chapter in volume 3 of the *Cyclone V Device Handbook*.

Watchdog Timers

The two watchdog timers are based on the Synopsys DesignWare APB Watchdog Timer (DW_apb_wdt) peripheral and offer the following features:

- 32-bit timer resolution
- Interrupt request
- Reset request
- Programmable time-out period up to approximately 86 seconds (assuming a 50 MHz clock)



For more information, refer to the *Watchdog Timer* chapter in volume 3 of the *Cyclone V Device Handbook*.

DMA Controller

The DMA controller provides high-bandwidth data transfers for modules without integrated DMA controllers. The DMA controller is based on the ARM Corelink™ DMA Controller (DMA-330) and offers the following features:

- Microcoded to support flexible transfer types
- Supports up to 8 channels
- Supports flow control with 31 peripherals handshake interfaces



For more information, refer to the *DMA Controller* chapter in volume 3 of the *Cyclone V Device Handbook*.

FPGA Manager

The FPGA manager offers the following features:

- Manages configuration of the FPGA portion of the device
- Mimics passive parallel 32-bit configuration
- Partial reconfiguration
- Compressed FPGA configuration images
- Advanced Encryption Standard (AES) encrypted FPGA configuration images
- Monitors configuration-related signals in FPGA
- Provides 32 general-purpose inputs and 32 general-purpose outputs to the FPGA fabric



For more information, refer to the *FPGA Manager* chapter in volume 3 of the *Cyclone V Device Handbook*.

Interface Peripherals

HPS provides the interface peripherals described in this section.

EMACs

The two EMACs are based on the Synopsys DesignWare 3504-0 Universal 10/100/1000 Ethernet MAC (DWC_gmac) and offer the following features:

- Supports 10-, 100-, and 1000-Mbps standards
- Supports RGMII external PHY interface
- Integrated DMA controllers



For more information, refer to the *Ethernet Media Access Controller* chapter in volume 3 of the *Cyclone V Device Handbook*.

USB Controllers

The two USB 2.0 On-The-Go (OTG) controllers are based on the Synopsys DesignWare Cores USB 2.0 Hi-Speed On-The-Go (DWC_otg) controller and offer the following features:

- Supports USB 2.0 host and device operation
- Dual-role device (device and host functions)
 - High-speed (480 Mbps)
 - Full-speed (12 Mbps)
 - Low-speed (1.5 Mbps)
 - Supports USB 1.1 (full-speed & low-speed)
- Integrated descriptor-based scatter-gather DMA (SGDMA)
- Support for external ULPI PHY
- Up to 16 bidirectional endpoints, including control endpoint

- Up to 16 host channels
- Supports generic root hub
- Automatic ping capability
- Configurable to OTG 1.3 and OTG 2.0 modes



For more information, refer to the *USB 2.0 OTG Controller* chapter in volume 3 of the *Cyclone V Device Handbook*.

I²C Controllers

The four I²C controllers are based on Synopsys DesignWare APB I²C (DW_apb_i2c) controller and offer the following features:

- Two controllers support I²C management interfaces
- Support both 100 Kbps and 400 Kbps modes
- Support both 7-bit and 10-bit addressing modes
 - No support for mixed-address mode
- Support master and slave operating mode
- Direct access for host processor
 - DMA controller may be used for large transfers



For more information, refer to the *I²C Controller* chapter in volume 3 of the *Cyclone V Device Handbook*.

UARTs

The two UART modules are based on Synopsys DesignWare APB Universal Asynchronous Receiver/Transmitter (DW_apb_uart) peripheral and offer the following features:

- 16550 compatible UART
 - Supports the auto flow control as specified in 16750 specification
- Supports IrDA 1.0 SIR mode
- Programmable baud rate up to 115.2 Kbps
- Direct access for host processor
 - DMA controller may be used for large transfers



For more information, refer to the *UART Controller* chapter in volume 3 of the *Cyclone V Device Handbook*.

CAN Controllers

The two CAN controllers are based on the Bosch® D_CAN controller and offer the following features:

- Compliant with CAN protocol specification 2.0 part A & B
- Programmable communication rate up to 1 Mbps

- Holds up to 128 messages
- Supports 11-bit standard and 29-bit extended identifiers
- Programmable interrupt scheme
- Direct access for host processor
 - DMA controller may be used for large transfers
- Available on certain device variants only



For more information, refer to the *Controller Area Network Controller* chapter in volume 4 of the *Cyclone V Device Handbook*.

SPI Master Controllers

The two SPI master controllers are based on Synopsys DesignWare Synchronous Serial Interface (SSI) controller (DW_apb_ssi) and offer the following features:

- Programmable data frame size from 4 to 16 bits
- Supports full and half duplex
- Support up to two chip selects
- Direct access for host processor
 - DMA controller may be used for large transfers



For more information, refer to the *SPI Controller* chapter in volume 3 of the *Cyclone V Device Handbook*.

SPI Slave Controllers

The two SPI slave controllers are based on Synopsys DesignWare Synchronous Serial Interface (SSI) controller (DW_apb_ssi) and offer the following features:

- Programmable data frame size from 4 to 16 bits
- Supports full and half duplex
- Direct access for host processor
 - DMA controller may be used for large transfers



For more information, refer to the *SPI Controller* chapter in volume 3 of the *Cyclone V Device Handbook*.

GPIO Interfaces

The three GPIO interfaces are based on Synopsys DesignWare APB General Purpose Programming I/O (DW_apb_gpio) peripheral and offer the following features:

- Supports digital de-bounce
- Configurable interrupt mode
- Supports up to 71 I/O pins and 14 input-only pins, based on device variant



For more information, refer to the *General-Purpose I/O Interface* chapter in volume 3 of the *Cyclone V Device Handbook*.

On-Chip Memory

On-chip memory consists of the two modules described in this section.

On-Chip RAM

The on-chip RAM offers the following features:

- 64 KB size
- 64-bit slave interface
- High performance for all burst lengths



For more information, refer to the *On-Chip Memory* chapter in volume 3 of the *Cyclone V Device Handbook*.

Boot ROM

The boot ROM offers the following features:

- 64 KB size
- Contains the code required to support HPS boot from cold or warm reset
- Used exclusively for booting the HPS



For more information, refer to the *On-Chip Memory* chapter in volume 3 of the *Cyclone V Device Handbook*.

Endian Support

The HPS is natively a little-endian system. All HPS slaves are little-endian.

The processors masters are software configurable to interpret data as little-endian or big-endian, byte-invariant (BE8). All other masters, including the USB interface, are little-endian.

The FPGA-to-HPS, HPS-to-FPGA, and lightweight HPS-to-FPGA interfaces are little-endian.


If a processor is set to BE8 mode, software must convert endianness for accesses to peripherals and DMA linked lists in memory.

The ARM Cortex-A9 MPU supports a single instruction to change the endianness of the processor and provides the REV and REV16 instructions to swap the endianness of bytes or half-words respectively. The MMU page tables are software configurable to be organized as little-endian or BE8.

The ARM DMA controller is software configurable to perform byte lane swapping during a transfer.

HPS-FPGA Interfaces

The HPS-FPGA interfaces provide a variety of communication channels between the HPS and the FPGA fabric. The HPS is highly integrated with the FPGA fabric, resulting in thousands of connecting signals. The HPS-FPGA interfaces include:

- FPGA-to-HPS bridge—a high-performance AXI bus with a configurable data width of 32-, 64-, and 128-bits, allowing the FPGA fabric to master transactions to the slaves in the HPS. This interface allows the FPGA fabric to have full visibility into the HPS address space. This interface also provides access to the coherent memory interface.
-  For information about the coherent memory interface, refer to the *Cortex-A9 MPU System* chapter in volume 3 of the *Cyclone V Device Handbook*.
- HPS-to-FPGA bridge—a high-performance AXI bus with a configurable data width of 32-, 64-, and 128-bits, allowing the HPS to master transactions to slaves in the FPGA fabric.
- Lightweight HPS-to-FPGA bridge—an AXI bus with a 32-bit fixed data width, allowing the HPS to master transactions to slaves in the FPGA fabric.
- FPGA-to-HPS SDRAM interface—a configurable interface to the MPFE of the SDRAM controller. You can configure the following parameters:
 - AXI-3 or Avalon® Memory-Mapped (Avalon-MM) protocol
 - Up to six ports
 - 32-, 64-, 128-, or 256-bit data width of each port
- FPGA clocks and resets—provide flexible clocks to and from the HPS.
- HPS-to-FPGA JTAG—allows the HPS to master the FPGA JTAG chain.
- TPIU trace—sends trace data created in the HPS to the FPGA fabric.
- FPGA System Trace Macrocell (STM) events—an interface that allows the FPGA fabric to send hardware events stored in the HPS trace using STM.
- FPGA cross-trigger—an interface that allows triggers to and from the CoreSight trigger system.
- DMA peripheral interface—multiple peripheral-request channels.
- FPGA manager interface—signals that communicate with FPGA fabric for boot and configuration.
- Interrupts—allow soft IP to supply interrupts directly to the MPU interrupt controller.
- MPU standby and events—signals that notify the FPGA fabric that the MPU is in standby mode and signals that wake up Cortex-A9 processors from a wait for event (WFE) state.

Address Map

The address map specifies the addresses of slaves, such as memory and peripherals, as viewed by the MPU and other masters. The HPS has multiple address spaces, defined in the following section.

Address Spaces

Table 1-1 shows the HPS address spaces and their sizes.

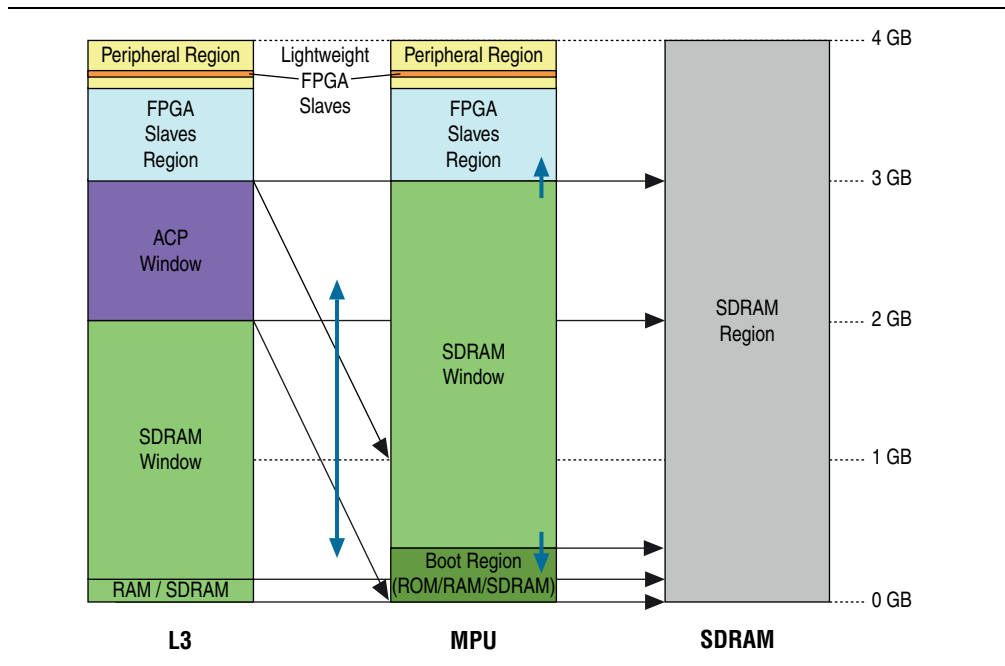
Table 1-1. HPS Address Spaces

Name	Description	Size
MPU	MPU subsystem	4 GB
L3	L3 interconnect	4 GB
SDRAM	SDRAM controller subsystem	4 GB

Address spaces are divided into one or more nonoverlapping contiguous regions. For example, the MPU address space has the peripheral, FPGA slaves, SDRAM window, and boot regions.

Figure 1-3 shows the relationships between the HPS address spaces. The figure is not to scale.

Figure 1-3. HPS Address Space Relationships



The window regions provide access to other address spaces. The thin black arrows indicate which address space is accessed by a window region (arrows point to accessed address space). For example, accesses to the ACP window in the L3 address space map to a 1 GB region of the MPU address space.

The SDRAM window in the MPU address space can grow and shrink at the top and bottom (short, blue vertical arrows) at the expense of the FPGA slaves and boot regions. For specific details, refer to “MPU Address Space”.

The ACP window can be mapped to any 1 GB region in the MPU address space (blue vertical bidirectional arrow), on gigabyte-aligned boundaries.

Table 1–2 shows the base address and size of each region that is common to the L3 and MPU address spaces.

Table 1–2. Common Address Space Regions

Identifier	Region Name	Base Address	Size
FPGASLAVES	FPGA slaves	0xC0000000	960 MB
LWFPGASLAVES	Lightweight FPGA slaves	0xFF200000	2 MB
PERIPH	Peripheral	0xFC000000	64 MB

SDRAM Address Space

The SDRAM address space is up to 4 GB. The entire address space can be accessed through the FPGA-to-HPS SDRAM interface from the FPGA fabric. The total amount of SDRAM addressable from the other address spaces varies. For specific details, refer to “MPU Address Space” and “L3 Address Space”.


MPU Address Space

The MPU address space is 4 GB and applies to addresses generated inside the MPU.


The MPU address space contains the following regions:

- The SDRAM window region provides access to a large, configurable portion of the 4 GB SDRAM address space. The MPU L2 cache controller contains a master connected to the L3 interconnect and a master connected to the SDRAM. The address filtering start and end registers in the L2 cache controller define the SDRAM window boundaries. The boundaries are megabyte-aligned. Addresses within the boundaries route to the SDRAM master. Addresses outside the boundaries route to the L3 interconnect master.

Figure 1–3 shows the reset values of the SDRAM window boundaries. By default, processor accesses to locations between 0x100000 (1 MB) to 0xC0000000 (3 GB) are made to the SDRAM controller, accesses to all other locations are made to the L3 interconnect. Addresses in the SDRAM window match addresses in the SDRAM address space. Thus, the lowest 1 MB of the SDRAM is not visible to the MPU unless the L2 address filter start register is set to 0.

 For more information about L2 address filtering, refer to the *Cortex-A9 MPU System* chapter in volume 3 of the *Cyclone V Device Handbook*.

- The boot region is 1 MB starting at address 0x0 and is visible to the MPU only when the L2 address filter start register is set to 0x100000. The L3 interconnect Global Programmers View (GPV) remap control register determines if the boot region is mapped to the on-chip RAM or the boot ROM.

 For information about the L3 GPV remap control register bits, refer to the *Interconnect* chapter in volume 3 of the *Cyclone V Device Handbook*.

The boot region is mapped to the boot ROM on reset. Only the lowest 64 KB of the boot region are legal addresses because the on-chip RAM and boot ROM are only 64 KB.



When the L2 address filter start register is set to 0, SDRAM obscures access to the boot region. This technique can be used to gain access to the lowest SDRAM addresses after booting completes.

- The FPGA slaves region provides access to 960 MB of slaves in the FPGA fabric through the HPS-to-FPGA bridge. If the top of the SDRAM window increases in the MPU address space (by writing to the L2 address filter end register), the lower portion of the FPGA slaves region is obscured from the MPU subsystem.
- The peripheral region contains 64 MB at the top of the address space. The peripheral region includes all slaves connected to the L3 interconnect, L4 buses, and internally-decoded MPU registers (SCU and L2). The boot ROM and on-chip RAM are always mapped into the peripheral region (independent of the boot region contents). The lightweight FPGA slaves are also mapped in the peripheral region and provide access to 2 MB of slaves in the FPGA fabric through the lightweight HPS-to-FPGA bridge.

Table 1-3 shows the base address and size of each MPU address space region that is not included in Table 1-2.

Table 1-3. MPU Default Address Space Regions

Identifier	Region Name	Base Address	Size
MPUBOOT	Boot region	0x00000000	1 MB
MPUSDRAM	SDRAM window	0x00100000	3071 MB

L3 Address Space

The L3 address space is 4 GB and applies to all L3 masters except the MPU subsystem.

The L3 address space configurations contain the following regions:

- The peripheral region is the same as the peripheral region in the MPU address space except that the boot ROM and internal MPU registers (SCU and L2) are not accessible.
- The FPGA slaves region provides access to 960 MB of slaves in the FPGA fabric through the HPS-to-FPGA bridge.
- The SDRAM window region is 2 GB and provides access to the bottom 2 GB of the SDRAM address space. The L3 interconnect GPV remap register determines if the 64 KB starting at address 0x0 is mapped to the on-chip RAM or the SDRAM. The SDRAM is mapped to address 0x0 on reset.



For information about the L3 GPV remap control register bits, refer to the *Interconnect* chapter in volume 3 of the *Cyclone V Device Handbook*.

- The ACP window region is 1 GB and provides access to a configurable gigabyte-aligned region of the MPU address space. Registers in the ACP ID mapper control which gigabyte-aligned region of the MPU address space is accessed by the ACP window region. The ACP window region is used by L3 masters to perform coherent accesses into the MPU address space.



For more information about the ACP ID mapper, refer to the *Cortex-A9 MPU System* chapter in volume 3 of the *Cyclone V Device Handbook*.

Table 1-4 shows the base address and size of each L3 address space region that is not included in Table 1-2.

Table 1-4. L3 Address Space Regions

Identifier	Region Name	Base Address	Size
L3SDRAM	SDRAM window	0x00000000	2 GB
L3LOWOCRAM	On-chip RAM when present	0x00000000	64 KB
L3ACP	ACP window	0x80000000	1 GB

Peripheral Region Address Map

Table 1-5 lists the slave identifier, slave title, base address, and size of each slave in the peripheral region. The Slave Identifier column lists the names used in the HPS register map. The Slave Title column contains the module name for modules with only one slave and module names plus a suffix for modules with more than one slave.

Table 1-5. Peripheral Region Address Map (Part 1 of 2)

Slave Identifier	Slave Title	Base Address	Size
STM	STM	0xFC000000	48 MB
DAP	DAP	0xFF000000	2 MB
LWFPGASLAVES	FPGA slaves accessed with lightweight FPGA-to-HPS AXI bridge	0xFF200000	2 MB
LWHPS2FPGAREGS	Lightweight FPGA-to-HPS AXI bridge GPV	0xFF400000	1 MB
HPS2FPGAREGS	HPS-to-FPGA AXI bridge GPV	0xFF500000	1 MB
FPGA2HPSREGS	FPGA-to-HPS AXI bridge GPV	0xFF600000	1 MB
EMAC0	EMAC0	0xFF700000	8 KB
EMAC1	EMAC1	0xFF702000	8 KB
SDMMC	SD/MMC	0xFF704000	4 KB
QSPIREGS	Quad SPI flash controller registers	0xFF705000	4 KB
FPGAMGRREGS	FPGA manager registers	0xFF706000	4 KB
ACPIDMAP	ACP ID mapper registers	0xFF207000	4 KB
GPIO0	GPIO0	0xFF208000	4 KB
GPIO1	GPIO1	0xFF209000	4 KB
GPIO2	GPIO2	0xFF20A000	4 KB
L3REGS	L3 interconnect GPV	0xFF800000	1 MB
NANDDATA	NAND controller data	0xFF900000	1 MB
QSPIDATA	Quad SPI flash data	0xFFA00000	1 MB
USB0	USB0 OTG controller registers	0xFFB00000	256 KB
USB1	USB1 OTG controller registers	0xFFB40000	256 KB
NANDREGS	NAND controller registers	0xFFB80000	64 KB
FPGAMGRDATA	FPGA manager configuration data	0xFFB90000	4 KB
CAN0	CAN0 controller registers	0xFFC00000	4 KB
CAN1	CAN1 controller registers	0xFFC01000	4 KB

Table 1–5. Peripheral Region Address Map (Part 2 of 2)

Slave Identifier	Slave Title	Base Address	Size
UART0	UART0	0xFFC02000	4 KB
UART1	UART1	0xFFC03000	4 KB
I2C0	I2C0	0xFFC04000	4 KB
I2C1	I2C1	0xFFC05000	4 KB
I2C2	I2C2	0xFFC06000	4 KB
I2C3	I2C3	0xFFC07000	4 KB
SPTIMER0	SP Timer0	0xFFC08000	4 KB
SPTIMER1	SP Timer1	0xFFC09000	4 KB
SDRREGS	SDRAM controller subsystem registers	0xFFC20000	128 KB
OSC1TIMER0	OSC1 Timer0	0xFFD00000	4 KB
OSC1TIMER1	OSC1 Timer1	0xFFD01000	4 KB
L4WD0	Watchdog0	0xFFD02000	4 KB
L4WD1	Watchdog1	0xFFD03000	4 KB
CLKMGR	Clock manager	0xFFD04000	4 KB
RSTMGR	Reset manager	0xFFD05000	4 KB
SYSMGR	System manager	0xFFD08000	16 KB
DMANONSECURE	DMA nonsecure registers	0xFFE00000	4 KB
DMASECURE	DMA secure registers	0xFFE01000	4 KB
SPIS0	SPI slave0	0xFFE02000	4 KB
SPIS1	SPI slave1	0xFFE03000	4 KB
SPIM0	SPI master0	0xFFF00000	4 KB
SPIM1	SPI master1	0xFFF01000	4 KB
SCANMGR	Scan manager registers	0xFFF02000	4 KB
ROM	Boot ROM	0xFFFD0000	64 KB
MPUSCU	MPU SCU registers	0xFFFE0000	8 KB
MPUL2	MPU L2 cache controller registers	0xFFFEF000	4 KB
OCRAM	On-chip RAM	0xFFFF0000	64 KB

Document Revision History

Table 1–6 shows the revision history for this document.

Table 1–6. Document Revision History

Date	Version	Changes
November 2012	1.3	Minor updates.
June 2012	1.2	Updated address spaces section.
May 2012	1.1	Added peripheral region address map.
January 2012	1.0	Initial release.

The hard processor system (HPS) clock generation is centralized in the clock manager. The clock manager is responsible for providing software-programmable clock control to configure all clocks generated in the HPS. Clocks are organized in clock groups. A clock group is a set of clock signals that originate from the same clock source. A phase-locked loop (PLL) clock group is a clock group where the clock source is a common PLL voltage-controlled oscillator (VCO).

Features of the Clock Manager

The clock manager offers the following features:

- Generates and manages clocks in the HPS
- Contains the following PLL clock groups:
 - Main—contains clocks for the Cortex™-A9 microprocessor unit (MPU) subsystem, level 3 (L3) interconnect, level 4 (L4) peripheral bus, and debug
 - Peripheral—contains clocks for PLL-driven peripherals
 - SDRAM—contains clocks for the SDRAM subsystem
- Allows scaling of the MPU subsystem clocks without disabling peripheral and SDRAM clock groups
- Generates clock gate controls for enabling and disabling most clocks
- Initializes and sequences clocks for the following events:
 - Cold reset
 - Safe mode request from reset manager on warm reset

- Allows software to program clock characteristics, such as the following items discussed later in this chapter:
 - Input clock source for SDRAM and peripheral PLLs
 - Multiplier range, divider range, and six post-scale counters for each PLL
 - Output phases for SDRAM PLL outputs
 - VCO enable for each PLL
 - Bypass modes for each PLL
 - Gate off individual clocks in all PLL clock groups
 - Clear loss of lock status for each PLL
 - Safe mode for hardware-managed clocks
 - General-purpose I/O (GPIO) debounce clock divide
- Allows software to observe the status of all writable registers
- Supports interrupting the MPU subsystem on PLL-lock and loss-of-lock
- Supports clock gating at the signal level



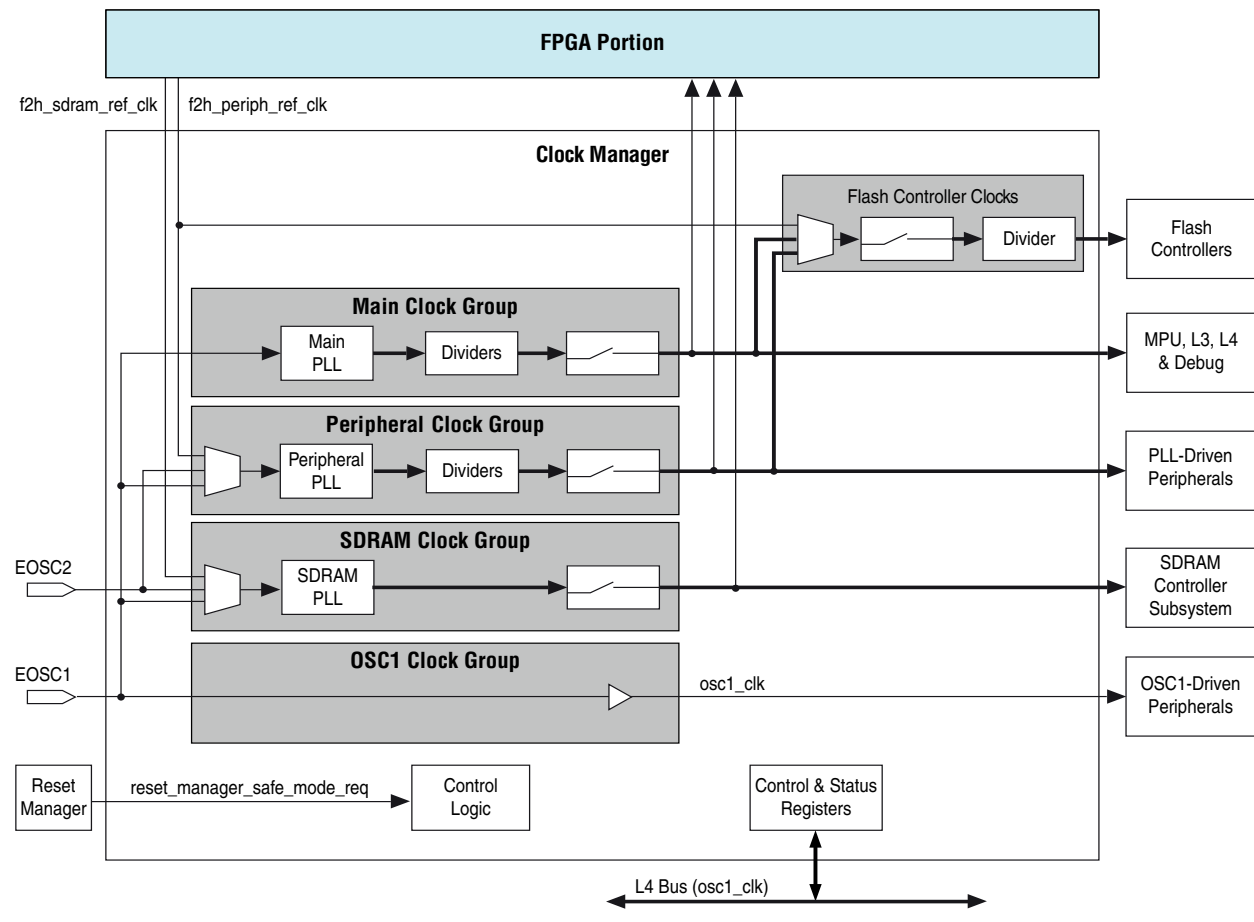
The clock manager is *not* responsible for the following functional behaviors:

- Selection or management of the clocks for the FPGA-to-HPS, HPS-to-FPGA, and FPGA-to-HPS SDRAM interfaces. The FPGA logic designer is responsible for selecting and managing these clocks.
- Software must not program the clock manager with illegal values. If it does, the behavior of the clock manager is undefined and could stop the operation of the HPS. The only guaranteed means for recovery from an illegal clock setting is a cold reset.
- When re-programming clock settings, there are no automatic glitch-free clock transitions. Software must follow a specific sequence to ensure glitch-free clock transitions. Refer to “[Hardware-Managed and Software-Managed Clocks](#)” on [page 2-5](#).

Clock Manager Block Diagram and System Integration

Figure 2-1 shows the major components of the clock manager and its integration in the HPS.

Figure 2-1. Clock Manager Block Diagram



The next section describes the functional blocks internal to the clock manager. Refer to Figure 2-3 to Figure 2-6 for more detailed versions of the grey boxes in Figure 2-1.

Functional Description of the Clock Manager

This section describes the functional operation of the clock manager.

Clock Manager Building Blocks

The clock manager has the following major building blocks.

PLLs

The clock manager contains three PLLs: main, peripherals, and SDRAM. These PLLs generate the majority of clocks in the HPS. There is no phase control between the clocks generated by the three PLLs.

Each PLL has the following features:

- Phase detector and output lock signal generation
- Registers to set VCO frequency
 - Multiplier range is 1 to 4096
 - Divider range is 1 to 64
- Six post-scale counters (C0-C5) with a range of 1 to 512
- PLL can be enabled to bypass all outputs to the `osc1_clk` clock for glitch-free transitions

The SDRAM PLL has the following additional feature:

- Phase shift of 1/8 per step
 - Phase shift range is 0 to 7

Equation 2-1 shows equations for F_{REF} , F_{VCO} , and F_{OUT} . The values for M , N , and C are stored in registers accessible to software.

Equation 2-1. F_{REF} , F_{VCO} , and F_{OUT} Equations

$$\begin{aligned}
 F_{REF} &= F_{IN} / N \\
 F_{VCO} &= F_{REF} \times M = F_{IN} \times M/N \\
 F_{OUT} &= F_{VCO} / (C_i \times K) = F_{REF} \times M / (C_i \times K) = (F_{IN} \times M) / (N \times C_i \times K)
 \end{aligned}$$

where:

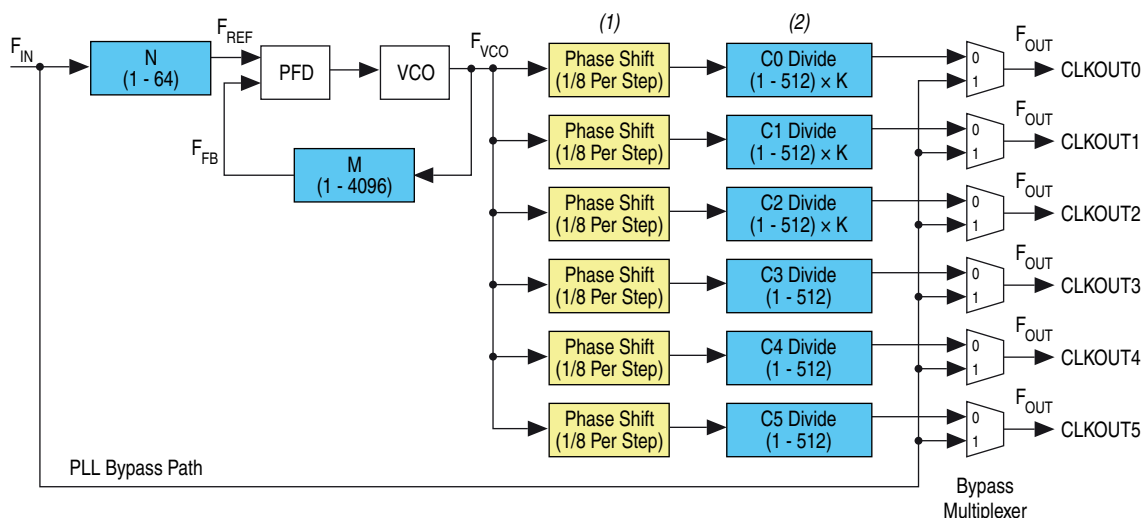
- (1) F_{VCO} = VCO frequency.
 - (2) F_{IN} = input frequency.
 - (3) F_{REF} = reference frequency.
 - (4) M = numerator, part of the clock feedback path.
 - (5) N = denominator, part of the input clock reference path.
 - (6) C_i = post-scale counter, where i is 0-5 for each of the six counters.
 - (7) K is an internal post-scale counter in the main PLL, where $K = 2$ for C0, and $K = 4$ for C1 and C2. $K = 1$ for C3, C4, and C5 in the main PLL and for all C_i counters in the peripheral and SDRAM PLLs.
-



Minimum and maximum VCO frequencies for the main, peripheral, and SDRAM PLLs vary by device speed grade. For specific details, refer the [Cyclone V Device Datasheet](#).

Figure 2-2 shows the block diagram of each PLL. Values listed for M , N , and C are actually one greater than the values stored in the CSRs.

Figure 2-2. PLL Block Diagram



Notes to Figure 2-2:

- (1) Phase shift is only available for SDRAM PLL outputs.
- (2) In the main PLL, $K=2$ for C0, and $K=4$ for C1 and C2. $K=1$ in the peripheral and SDRAM PLLs.

Dividers

Dividers subdivide the C0-C5 clocks produced by the PLL to lower frequencies. The main PLL C0-C2 clocks have an additional internal post-scale counter.

Clock Gating

Clock gating enables and disables clock signals.

Control and Status Registers

The clock manager contains registers used to configure and observe the clock manager.

Hardware-Managed and Software-Managed Clocks

When changing values on clocks, the terms *hardware-managed* and *software-managed* define who is responsible for successful transitions. Software-managed clocks require that software manually gate off any clock affected by the change, wait for any PLL lock if required, then gate the clocks back on. Hardware-managed clocks use hardware to ensure that a glitch-free transition to a new clock value occurs. There are three hardware-managed sets of clocks in the HPS, namely, clocks generated from the main PLL outputs C0, C1, and C2. All other clocks in the HPS are software-managed clocks.

Clock Groups

The clock manager contains one clock group for each PLL and one clock group for the EOSC1 pin.

OSC1 Clock Group

The clock in the OSC1 clock group is derived directly from the EOSC1 pin. This clock is never gated or divided. It is used as a PLL input and also by HPS logic that does not operate on a clock output from a PLL.

Table 2-1 lists the clock in the OSC1 clock group.

Table 2-1. OSC1 Clock Group Clock

Name	Frequency	Clock Source	Destination
osc1_clk	10 to 50 MHz	EOSC1 pin	OSC1-driven peripherals listed in Table 2-9 on page 2-14

Main Clock Group

The main clock group consists of a PLL, dividers, and clock gating. The clocks in the main clock group are derived from the main PLL. The main PLL is always sourced from the EOSC1 pin of the device.

Table 2-2 lists the main PLL output assignments.

Table 2-2. Main PLL Output Assignments

PLL	Output Counter	Clock Name	Frequency	Phase Shift Control
Main	C0	mpu_base_clk	osc1_clk to varies ⁽¹⁾	No
	C1	main_base_clk	osc1_clk to varies ⁽¹⁾	No
	C2	dbg_base_clk	osc1_clk/4 to mpu_base_clk/2	No
	C3	main_qspi_base_clk	Up to 432 MHz	No
	C4	main_nand_sdmmc_base_clk	Up to 250 MHz for the NAND flash controller and up to 200 MHz for the SD/MMC controller	No
	C5	cfg_h2f_user0_base_clk	osc1_clk to 125 MHz for driving configuration and 100 MHz for the user clock	No

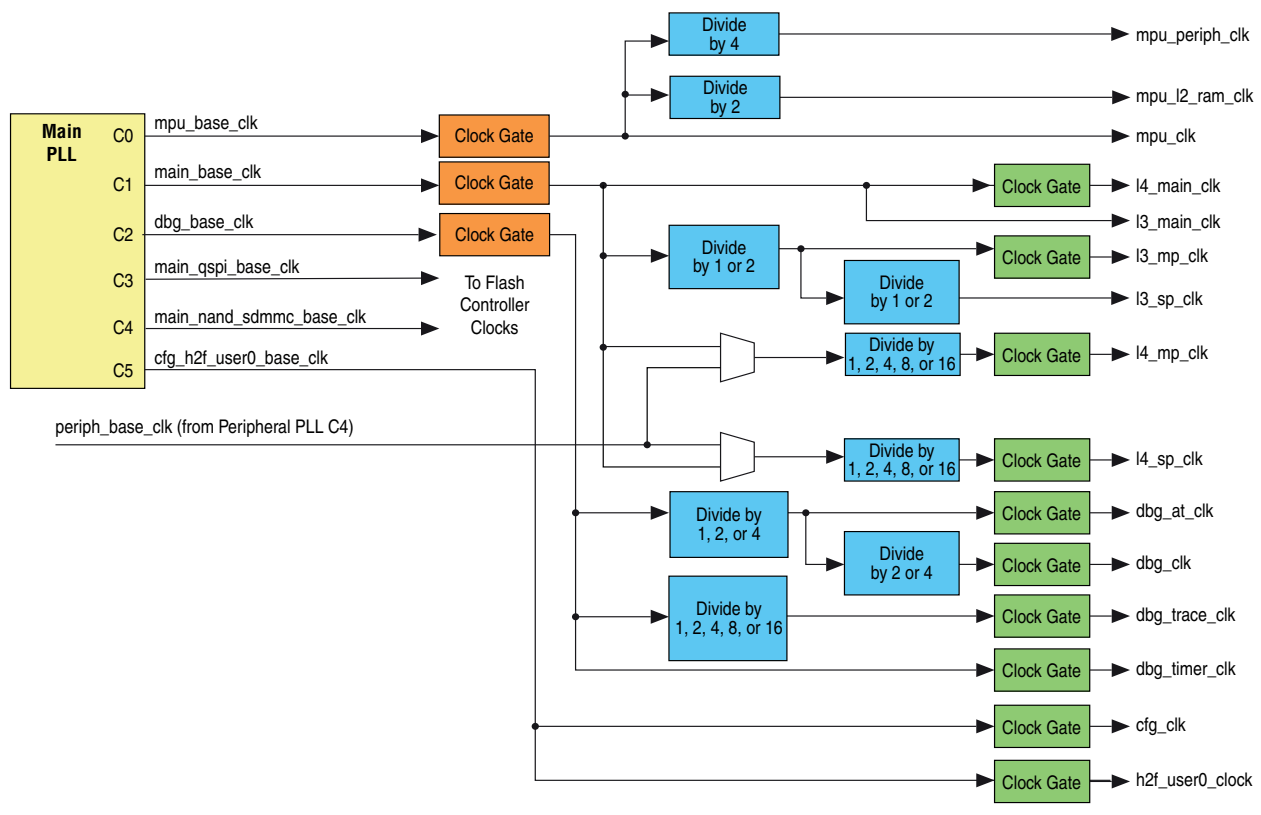
Note to Table 2-2:

(1) The maximum frequency depends on the speed grade of the device.

The counter outputs from the main PLL can have their frequency further divided by programmable dividers external to the PLL. Transitions to a different divide value occur on the fastest output clock, one clock cycle prior to the slowest clock's rising edge. For example, cycle 15 of the divide-by-16 divider for the main C2 output and cycle 3 of the divide-by-4 divider for the main C0 output.

Figure 2-3 shows how each counter output from the main PLL can have its frequency further divided by programmable post-PLL dividers. Green-colored clock gating logic is directly controlled by software writing to a register. Orange-colored clock gating logic is controlled by hardware. Orange-colored clock gating logic allows hardware to seamlessly transition a synchronous set of clocks, for example, all the MPU subsystem clocks.

Figure 2-3. Main Clock Group Divide and Gating



The clocks derived from main PLL C0-C2 outputs are hardware-managed, meaning hardware ensures that a clean transition occurs, and can have the following control values changed dynamically by software write accesses to the control registers:

- PLL bypass
- PLL numerator, denominator, and counters
- External dividers

For these registers, hardware detects that the write has occurred and performs the correct sequence to ensure that a glitch-free transition to the new clock value occurs. These clocks can pause during the transition.

Table 2-3 lists the clocks in the main clock group.

Table 2-3. Main Clock Group Clocks

System Clock Name	Frequency	Constraints and Notes
mpu_clk	Main PLL C0	Clock for MPU subsystem, including CPU0 and CPU1
mpu_l2_ram_clk	mpu_clk/2	Clock for MPU level 2 (L2) RAM
mpu_periph_clk	mpu_clk/4	Clock for MPU snoop control unit (SCU) peripherals, such as the general interrupt controller (GIC)
l3_main_clk	Main PLL C1	Clock for L3 main switch
l3_mp_clk	l3_main_clk or l3_main_clk/2	Clock for L3 master peripherals (MP) switch
l3_sp_clk	l3_mp_clk or l3_mp_clk/2	Clock for L3 slave peripherals (SP) switch
l4_main_clk	Main PLL C1	Clock for L4 main bus
l4_mp_clk	osc1_clk/16 to 100 MHz divided from main PLL C1 or peripheral PLL C4	Clock for L4 MP bus
l4_sp_clk	osc1_clk/16 to 100 MHz divided from main PLL C1 or peripheral PLL C4	Clock for L4 SP bus
dbg_at_clk	osc1_clk/4 to main PLL C2/2	Clock for CoreSight™ debug trace bus
dbg_trace_clk	osc1_clk/16 to main PLL C2	Clock for CoreSight™ debug Trace Port Interface Unit (TPIU)
dbg_timer_clk	osc1_clk to main PLL C2	Clock for the trace timestamp generator
dbg_clk	dbg_at_clk/2 or dbg_at_clk/4	Clock for Debug Access Port (DAP) and debug peripheral bus
main_qspi_clk	Main PLL C3	Quad SPI flash internal logic clock
main_nand_sdmmc_clk	Main PLL C4	Input clock to flash controller clocks block
cfg_clk	osc1_clk to 125_MHz divided from main PLL C5	FPGA manager configuration clock
h2f_user0_clock	osc1_clk to 100_MHz divided from main PLL C5	Auxiliary user clock to the FPGA fabric

Changing Values That Affect Main Clock Group PLL Lock

To change any value that affects VCO lock of the main clock group PLL, including the hardware-managed clocks, software must put the main PLL in bypass mode, which causes all the main PLL output clocks to be driven by the `osc1_clk` clock. Software must detect PLL lock by reading the lock status register prior to taking the main PLL out of bypass mode.

Once a PLL is locked, changes to any PLL VCO frequency that are 20 percent or less do not cause the PLL to lose lock. Iteratively changing the VCO frequency in increments of 20 percent or less allow a slow ramp of the VCO base frequency without loss of lock. For example, to change a VCO frequency by 40% without losing lock, change the frequency by 20%, then change it again by 16.7%.

Peripheral Clock Group

The peripheral clock group consists of a PLL, dividers, and clock gating. The clocks in the peripheral clock group are derived from the peripheral PLL. The peripheral PLL can be programmed to be sourced from the EOSC1 pin, the EOSC2 pin, or the f2h_periph_ref_clk clock provided by the FPGA fabric.

The counter outputs from the main PLL can have their frequency further divided by external dividers. Transitions to a different divide value occur on the fastest output clock, one clock cycle prior to the slowest clock's rising edge. For example, cycle 15 of the divide-by-16 divider for the main C2 output and cycle 3 of the divide-by-4 divider for the C1 output.

Table 2-4 lists the Peripheral PLL output assignments.

Table 2-4. Peripheral PLL Output Assignments

PLL	Output Counter	Clock Name	Frequency	Phase Shift Control
Peripheral	C0	emac0_base_clk	Up to 250 MHz	No
	C1	emac1_base_clk	Up to 250 MHz	No
	C2	periph_qspi_base_clk	Up to 432 MHz	No
	C3	periph_nand_sdmmc_base_clk	Up to 250 MHz for the NAND flash controller and up to 200 MHz for the SD/MMC controller	No
	C4	periph_base_base_clk	Up to 240 MHz for the SPI masters and up to 200 MHz for the scan manager	No
	C5	h2f_user1_base_clk	osc1_clk to 100 MHz	No

Figure 2-4 shows programmable post-PLL dividers and clock gating for the peripheral clock group. Clock gate blocks in the diagram indicate clocks which may be gated off under software control. Software is expected to gate these clocks off prior to changing any PLL or divider settings that might create incorrect behavior on these clocks.

Figure 2-4. Peripheral Clock Group Divide and Gating

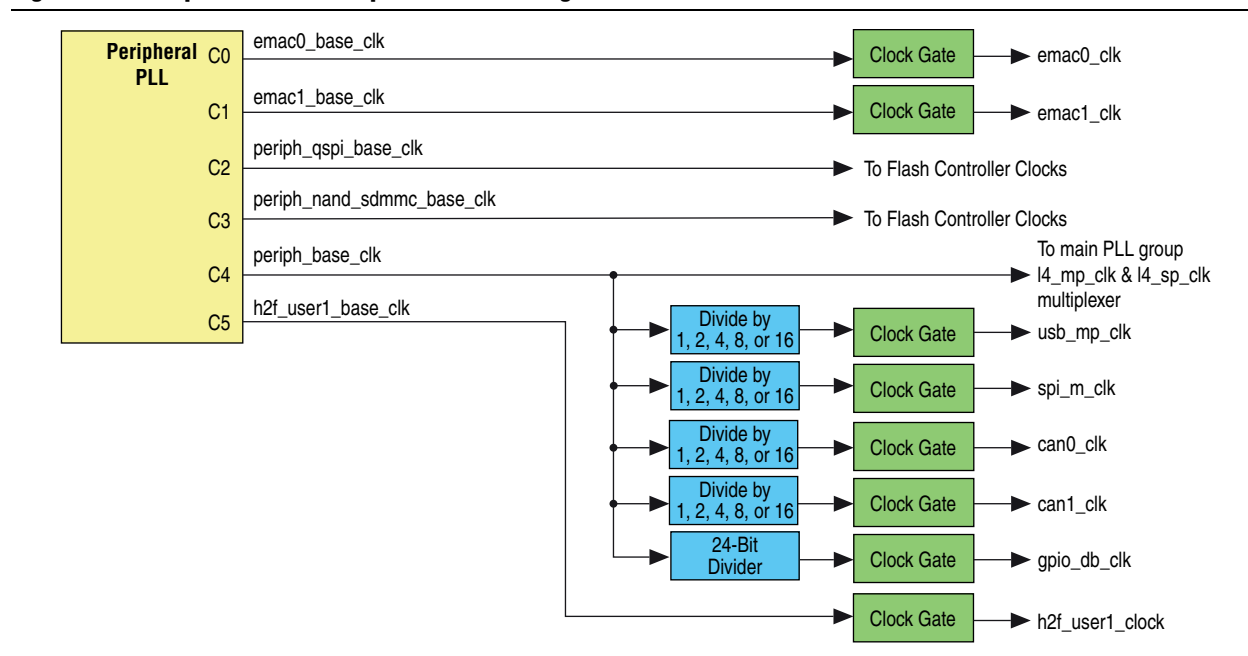


Table 2-5 lists the clocks in the peripheral clock group.

Table 2-5. Peripheral Clock Group Clocks (Part 1 of 2)

System Clock Name	Frequency	Divided From	Constraints and Notes
usb_mp_clk	Up to 200 MHz	Peripheral PLL C4	Clock for USB
spi_m_clk	Up to 240 MHz for the SPI masters and up to 200 MHz for the scan manager	Peripheral PLL C4	Clock for L4 SPI master bus and scan manager
emac0_clk	Up to 250 MHz	Peripheral PLL C0	EMAC0 clock. The 250 MHz clock is divided internally by the EMAC into the typical 125/25/2.5 MHz speeds for 1000/100/10 Mbps operation.
emac1_clk	Up to 250 MHz	Peripheral PLL C1	EMAC1 clock. The 250 MHz clock is divided internally by the EMAC into the typical 125/25/2.5 MHz speeds for 1000/100/10 Mbps operation.
l4_mp_clk	Up to 100 MHz	Main PLL C1 or peripheral PLL C4	Clock for L4 master peripheral bus
l4_sp_clk	Up to 100 MHz	Main PLL C1 or peripheral PLL C4	Clock for L4 slave peripheral bus
can0_clk	Up to 100 MHz	Peripheral PLL C4	Controller area network (CAN) controller 0 clock

Table 2-5. Peripheral Clock Group Clocks (Part 2 of 2)

System Clock Name	Frequency	Divided From	Constraints and Notes
can1_clk	Up to 100 MHz	Peripheral PLL C4	CAN controller 1 clock
gpio_db_clk	Up to 32 KHz	Peripheral PLL C4	Used to debounce GPIO0, GPIO1, and GPIO2
h2f_user1_clock	Peripheral PLL C5	Peripheral PLL C5	Auxiliary user clock to the FPGA fabric

SDRAM Clock Group

The SDRAM clock group consists of a PLL and clock gating. The clocks in the SDRAM clock group are derived from the SDRAM PLL. The SDRAM PLL can be programmed to be sourced from the EOSC1 pin, the EOSC2 pin, or the f2h_sdr_ref_clk clock provided by the FPGA fabric.

The counter outputs from the SDRAM PLL can be gated off directly under software control. The divider values for each clock are set by registers in the clock manager.

Table 2-6 lists the SDRAM PLL output assignments.

Table 2-6. SDRAM PLL Output Assignments

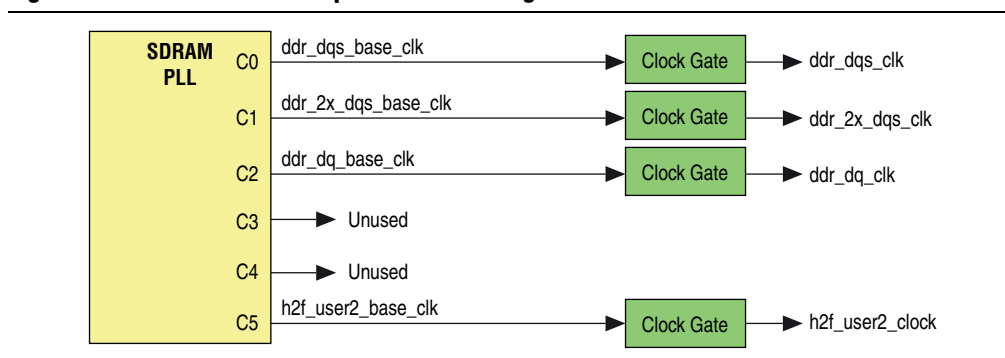
PLL	Output Counter	Clock Name	Frequency	Phase Shift Control
SDRAM	C0	ddr_dqs_base_clk	Up to varies ⁽¹⁾	Yes
	C1	ddr_2x_dqs_base_clk	Up to ddr_dqs_base_clk x 2	Yes
	C2	ddr_dq_base_clk	Up to ddr_dqs_base_clk	Yes
	C5	h2f_user2_base_clk	osc1_clk to varies ⁽¹⁾	Yes

Note to Table 2-6:

(1) The maximum frequency depends on the speed grade of the device.

Figure 2-5 shows clock gating for SDRAM PLL clock group. Clock gate blocks in the diagram indicate clocks which may be gated off under software control. Software is expected to gate these clocks off prior to changing any PLL or divider settings that might create incorrect behavior on these clocks.

Figure 2-5. SDRAM Clock Group Divide and Gating



The SDRAM PLL output clocks can be phase shifted in real time in increments of 1/8 the VCO frequency. Maximum number of phase shift increments is 4096.

Table 2-7 lists the clocks in the SDRAM clock group.

Table 2-7. SDRAM Clock Group Clocks

Name	Frequency	Constraints and Notes
ddr_dqs_clk	SDRAM PLL C0	Clock for MPFE, single-port controller, CSR access, and PHY
ddr_2x_dqs_clk	SDRAM PLL C1	Clock for PHY
ddr_dq_clk	SDRAM PLL C2	Clock for PHY
h2f_user2_clock	SDRAM PLL C5	Auxiliary user clock to the FPGA fabric

Flash Controller Clocks

Flash memory peripherals can be driven by the main PLL, the peripheral PLL, or from clocks provided by the FPGA fabric, as shown in Figure 2-6.

Figure 2-6. Flash Peripheral Clock Divide and Gating

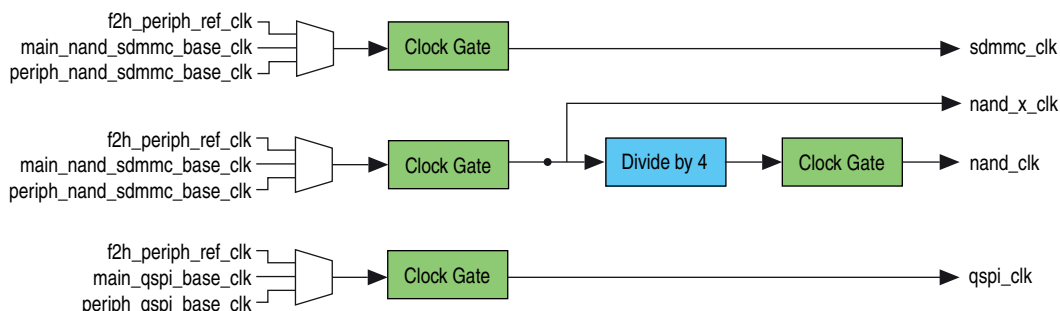


Table 2-8 lists the flash controller clocks.

Table 2-8. Flash Controller Clocks

System Clock Name	Frequency	Divided From	Constraints and Notes
qspi_clk	Up to 432 MHz	Peripheral PLL C2, main PLL C3, or f2h_periph_ref_clk	Clock for quad SPI, typically 108 and 80 MHz
nand_x_clk	Up to 250 MHz	Peripheral PLL C3, main PLL C4, or f2h_periph_ref_clk	NAND flash controller master and slave clock
nand_clk	nand_x_clk/4	Peripheral PLL C3, main PLL C4, or f2h_periph_ref_clk	Main clock for NAND flash controller, sets base frequency for NAND transactions
sdmmc_clk	Up to 200 MHz	Peripheral PLL C3, main PLL C4, or f2h_periph_ref_clk	<ul style="list-style-type: none"> ■ Less than or equal to memory maximum operating frequency ■ 45% to 55% duty cycle ■ Typical frequencies are 26 and 52 MHz ■ SD/MMC has a subclock tree divided down from this clock

Resets

Cold Reset

Cold reset places the hardware-managed clocks into safe mode, the software-managed clocks into their default state, and asynchronously resets all registers in the clock manager.

For more information, refer to “[Safe Mode](#)”.

Warm Reset

Registers in the clock manager control how the clock manager responds to warm reset. Typically, software places the clock manager into a safe state in order to generate a known set of clocks for the ROM code to boot the system. The behavior of the system on warm reset as a whole, including how the FPGA fabric, boot code, and debug systems are configured to behave, must be carefully considered when choosing how the clock manager responds to warm reset.

The reset manager can request that the clock manager go into safe mode as part of the reset manager’s warm reset sequence. Before asserting safe mode to the clock manager, the reset manager ensures that the reset signal is asserted on all modules that receive warm reset.



For more information, refer to “Reset Sequencing” in the [Reset Manager](#) chapter in volume 3 of the *Cyclone V Device Handbook*.

Safe Mode

Safe mode is enabled in the HPS by the assertion of a safe mode request from the reset manager or by a cold reset. Assertion of the safe mode request from the reset manager sets the safe mode bit in the clock manager control register. No other control register bits are affected by the safe mode request from the reset manager.

When safe mode is enabled, the main PLL hardware-managed clocks (C0-C2) are bypassed to the `osc1_clk` clock and are directly generated from the `osc1_clk` clock. While in safe mode, clock manager register settings, which control clock behavior, are not changed. However, the hardware bypasses these settings and uses safe, default settings.

The hardware-managed clocks are forced to their safe mode values such that the following conditions occur:

- The hardware-managed clocks are bypassed to the `osc1_clk` clock, including counters in the main PLL.
- Programmable dividers select the reset default values.
- The flash controller clocks multiplexer selects the output from the peripheral PLL.
- All clocks are enabled.

A write by software is the only way to clear the safe mode bit (`safemode`) of the `ctrl` register.



Before coming out of safe mode, all registers and clocks need to be configured correctly. It is possible to program the clock manager in such a way that only a cold reset can return the clocks to a functioning state. Altera strongly recommends using Altera-provided libraries to configure and control HPS clocks.

Interrupts

The clock manager provides one interrupt output, enabled using the interrupt enable register (intren). The source of the interrupt is six inputs, namely, an achieving lock and a losing lock bit in the interrupt status register (inter) for each PLL.

Clock Usage By Module

Table 2-9 lists every clock input generated by the clock manager to all modules in the HPS. System clock names are global for the entire HPS and system clocks with the same name are phase-aligned at all endpoints.

Table 2-9. Clock Usage By Module (Part 1 of 3)

Module Name	System Clock Name	Use
MPU subsystem	mpu_clk	Main clock for the MPU subsystem
	mpu_periph_clk	Clock for peripherals inside the MPU subsystem
	dbg_at_clk	Trace bus clock
	dbg_clk	Debug clock
	mpu_l2_ram_clk	Clock for the L2 cache and Accelerator Coherency Port (ACP) ID mapper
	l4_mp_clk	Clock for the ACP ID mapper control slave
Interconnect	l3_main_clk	Clock for the L3 main switch
	dbg_at_clk	Clock for the System Trace Macrocell (STM) slave and Embedded Trace Router (ETR) master connections
	dbg_clk	Clock for the DAP master connection
	l3_mp_clk	Clock for the L3 master peripheral switch
	l4_mp_clk	Clock for the L4 MP bus, Secure Digital (SD) / MultiMediaCard (MMC) master, and EMAC masters
	usb_mp_clk	Clock for the USB masters and slaves
	nand_x_clk	Clock for the NAND master
	cfg_clk	Clock for the FPGA manager configuration data slave
	l3_sp_clk	Clock for the L3 slave peripheral switch
	l3_main_clk	Clock for the L4 SPIS bus master
	mpu_l2_ram_clk	Clock for the ACP ID mapper slave and L2 master connections
	osc1_clk	Clock for the L4 OSC1 bus master
	spi_m_clk	Clock for the L4 SPIM bus master
	l4_sp_clk	Clock for the L4 SP bus master
	l4_mp_clk	Clock for the quad SPI bus slave
Boot ROM	l3_main_clk	Clock for the boot ROM
On-chip RAM	l3_main_clk	Clock for the on-chip RAM

Table 2–9. Clock Usage By Module (Part 2 of 3)

Module Name	System Clock Name	Use
DMA controller	l4_main_clk	Clock for the DMA
	dbg_at_clk	Clock synchronous to the STM module
	l4_mp_clk	Clock synchronous to the quad SPI flash
FPGA manager	cfg_clk	Clock for the control block (CB) data interface and configuration data slave
	l4_mp_clk	Clock for the control slave
HPS-to-FPGA bridge	l3_main_clk	Clock for the data slave
	l4_mp_clk	Clock for the global programmer's view (GPV) slave
FPGA-to-HPS bridge	l3_main_clk	Clock for the data master
	l4_mp_clk	Clock for the GPV slave
Lightweight HPS-to-FPGA bridge	l4_mp_clk	Clock for the GPV masters, and the data and GPV slave
Quad SPI flash controller	l4_mp_clk	Clock for the control slave
	qspi_clk	Reference clock for serialization
SD/MMC controller	l4_mp_clk	Clock for the master and slave
	sdmmc_clk	Clock for the SD/MMC internal logic
EMAC 0	l4_mp_clk	Clock for the master
	emac0_clk	EMAC 0 internal logic clock
	oscl_clk	IEEE 1588 timestamp clock
EMAC 1	l4_mp_clk	Clock for the master
	emac1_clk	EMAC 1 internal logic clock
	oscl_clk	IEEE 1588 timestamp clock
USB 0	usb_mp_clk	Clock for the master and slave
USB 1	usb_mp_clk	Clock for the master and slave
NAND flash controller	nand_x_clk	NAND high-speed master and slave clock
	nand_clk	NAND flash clock
OSC1 timer 0	oscl_clk	Clock for the OSC1 timer 0
OSC1 timer 1	oscl_clk	Clock for the OSC1 timer 1
SP timer 0	l4_sp_clk	Clock for the SP timer 0
SP timer 1	l4_sp_clk	Clock for the SP timer 1
I ² C controller 0	l4_sp_clk	Clock for the I ² C 0
I ² C controller 1	l4_sp_clk	Clock for the I ² C 1
I ² C controller 2	l4_sp_clk	Clock for the I ² C 2
I ² C controller 3	l4_sp_clk	Clock for the I ² C 3
UART controller 0	l4_sp_clk	Clock for the UART 0
UART controller 1	l4_sp_clk	Clock for the UART 1
CAN controller 0	l4_sp_clk	Clock for the slave
	can0_clk	CAN 0 controller clock
CAN controller 1	l4_sp_clk	Clock for the slave
	can1_clk	CAN 1 controller clock

Table 2–9. Clock Usage By Module (Part 3 of 3)

Module Name	System Clock Name	Use
GPIO interface 0	l4_mp_clk	Clock for the slave
	gpio_db_clk	Debounce clock
GPIO interface 1	l4_mp_clk	Clock for the slave
	gpio_db_clk	Debounce clock
GPIO interface 2	l4_mp_clk	Clock for the slave
	gpio_db_clk	Debounce clock
System manager	oscl_clk	Clock for the system manager
SDRAM subsystem	l4_sp_clk	Clock for the control slave
	ddr_dq_clk	Off-chip data clock
	ddr_dqs_clk	Clock for the MPFE, single-port controller, CSRs, and PHY
	ddr_2x_dqs_clk	Off-chip strobe data clock
	mpu_l2_ram_clk	Clock for the slave connected to MPU subsystem L2 cache
	l3_main_clk	Clock for the slave connected to L3 interconnect
L4 watchdog timer 0	oscl_clk	Clock for the L4 watchdog timer 0
L4 watchdog timer 1	oscl_clk	Clock for the L4 watchdog timer 1
SPI master controller 0	spi_m_clk	Clock for the SPI master 0
SPI master controller 1	spi_m_clk	Clock for the SPI master 1
SPI slave controller 0	l4_main_clk	Clock for the SPI slave 0
SPI slave controller 1	l4_main_clk	Clock for the SPI slave 1
Debug subsystem	l4_mp_clk	System bus clock
	dbg_clk	Debug clock
	dbg_at_clk	Trace bus clock
	dbg_trace_clk	Trace port clock
Reset manager	oscl_clk	Clock for the reset manager
	l4_sp_clk	Clock for the slave
Scan manager	spi_m_clk	Clock for the scan manager
Timestamp generator	dbg_timer_clk	Clock for the timestamp generator

Clock Manager Address Map and Register Definitions



The address map and register definitions reside in the [hps.html](#) file that accompanies this handbook volume. Click the link to open the file.

To view the module description and base address, scroll to and click the link for the following module instance:

■ clkmgr

To then view the register and field descriptions, scroll to and click the register names. The register addresses are offsets relative to the base address of each module instance.



The base addresses of all modules are also listed in the *Introduction to the Hard Processor System* chapter in volume 3 of the *Cyclone V Device Handbook*.

Document Revision History

Table 2-10 shows the revision history for this document.

Table 2-10. Document Revision History

Date	Version	Changes
November 2012	1.2	Minor updates.
May 2012	1.1	<ul style="list-style-type: none">■ Reorganized and expanded functional description section.■ Added address map and register definitions section.
January 2012	1.0	Initial release.

This chapter provides an overview of HPS reset manager. The reset manager generates module reset signals based on reset requests from the various sources in the HPS and FPGA fabric, and software writing to the module-reset control registers. The reset manager ensures that a reset request from the FPGA fabric can occur only after the FPGA portion of the system-on-a-chip (SoC) device is configured.

The HPS contains three reset domains. Each reset domain can be reset independently. Each register in the HPS that can be reset belongs to one particular reset domain.

Table 3–1 shows the HPS reset domains.

Table 3–1. HPS Reset Domains

Domain Name	Domain Logic
TAP	JTAG test access port (TAP) controller, which is used by the debug access port (DAP).
Debug	All debug logic including most of the DAP, CoreSight™ components connected to the debug peripheral bus, trace, the microprocessor unit (MPU) subsystem, and the FPGA fabric.
System	All HPS logic except what is in the TAP and debug reset domains. Includes nondebug logic in the FPGA fabric connected to the HPS reset signals.

The HPS supports the following reset types:

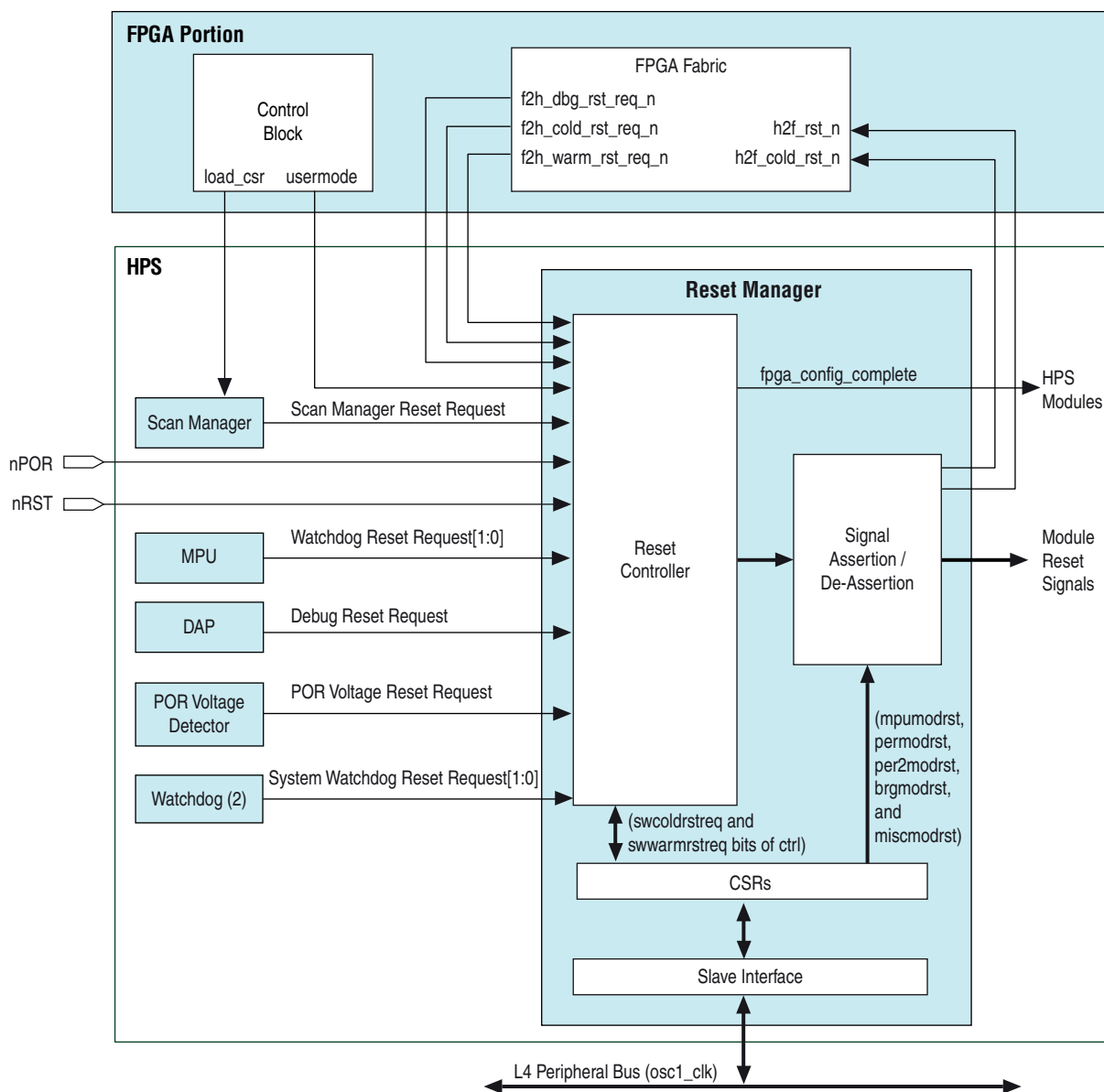
- Cold reset (power-on reset)
 - Used to ensure the HPS is placed in a default state sufficient for software to boot
 - Triggered by a power-on reset and other sources
 - Resets all HPS logic that can be reset
 - Affects all reset domains
- Warm reset
 - Occurs after HPS has already been through a cold reset
 - Used to recover system from a non-responsive condition
 - Resets a subset of the HPS state reset by a cold reset
 - Only affects the system reset domain, which allows debugging (including trace) to operate through the warm reset

- Debug reset
 - Occurs after HPS has already been through a cold reset
 - Used to recover debug logic from a non-responsive condition
 - Only affects the debug reset domain

Reset Manager Block Diagram and System Integration

Figure 3-1 shows a block diagram of the reset manager in the SoC device.

Figure 3-1. Reset Manager Block Diagram



Note to Figure 3-1:

(1) Reset-related handshaking signals to other HPS modules and to the clock manager module are omitted from this figure for clarity.

HPS External Reset Sources

Table 3–2 describes the reset sources external to the HPS. All signals are synchronous to the `osc1_clk` clock.

Table 3–2. HPS External Reset Sources

Source	Description
<code>f2h_cold_rst_req_n</code>	Cold reset request from FPGA fabric (active low)
<code>f2h_warm_rst_req_n</code>	Warm reset request from FPGA fabric (active low)
<code>f2h_dbg_rst_req_n</code>	Debug reset request from FPGA fabric (active low)
<code>h2f_cold_rst_n</code>	Cold-only reset to FPGA fabric (active low)
<code>h2f_rst_n</code>	Cold or warm reset to FPGA fabric (active low)
<code>load_csr</code>	Cold-only reset from FPGA control block (CB) and scan manager
<code>nPOR</code>	Power-on reset pin (active low)
<code>nRST</code>	Warm reset pin (active low)



The reset signals from the HPS to the FPGA fabric must be synchronized to your user logic clock domain.

Reset Controller

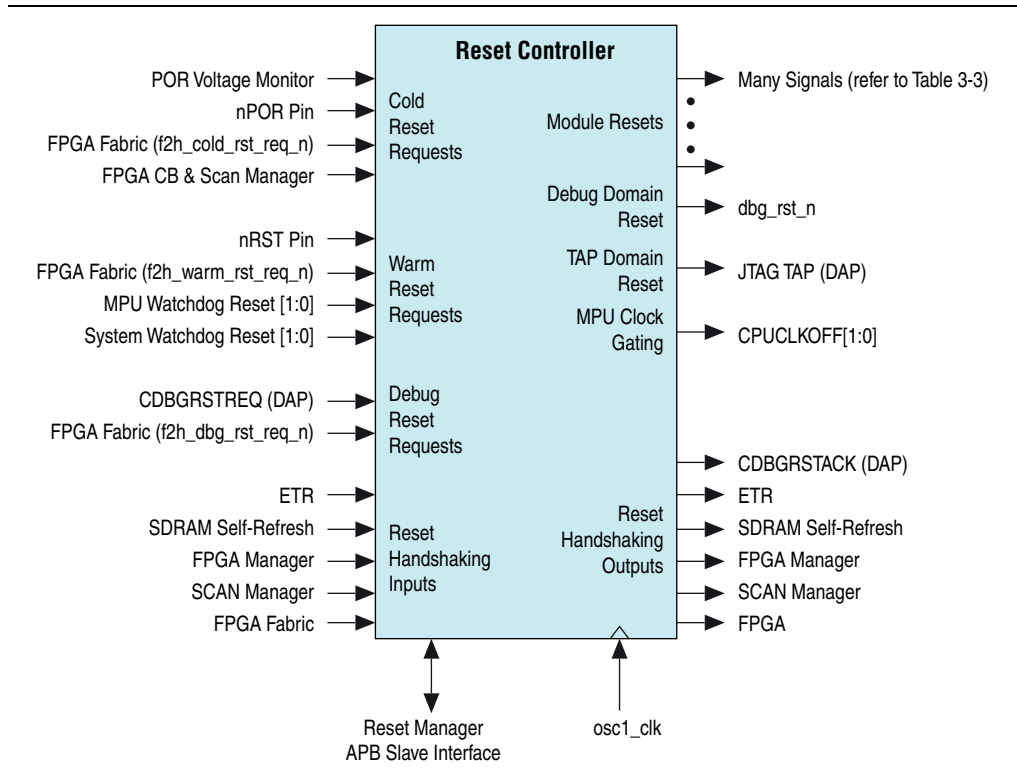
The reset controller performs the following functions:

- Accepts reset requests from the FPGA CB, FPGA fabric, modules in the HPS, and reset pins
- Generates an individual reset signal for each module instance for all modules in the HPS
- Provides reset handshaking signals to support system reset behavior

The reset controller generates module reset signals from external reset requests and internal reset requests. External reset requests originate from sources external to the reset manager. Internal reset requests originate from control registers in the reset manager.

Figure 3–2 shows the reset controller signals.

Figure 3–2. Reset Controller Signals



The reset controller supports the following cold reset requests:

- Power-on reset (POR) voltage monitor
- Cold reset request pin (nPOR)
- FPGA fabric
- FPGA CB and scan manager
- Software cold reset request bit (swcoldrstreq) of the control register (ctrl1)

The reset controller supports the following warm reset requests:

- Warm reset request pin (nRST)
- FPGA fabric
- Software warm reset request bit (swwarmrstreq) of the ctrl1 register
- MPU watchdog reset requests for CPU0 and CPU1
- System watchdog timer 0 and 1 reset requests

The reset controller supports the following debug reset requests:

- CDBGIRSTREQ from DAP
- FPGA fabric

Module Reset Signals

Table 3–3 lists the module reset signals. The module reset signals are organized in groups for the MPU, peripherals, bridges, the level 3 (L3) interconnect, and miscellaneous.

Checkmarks in the Cold Reset, Warm Reset, and Debug Reset columns denote reset signals asserted by each type of reset. For example, writing a 1 to the `swwarmrstreq` bit in the `ctrl` register resets all the modules that have a checkmark in the Warm Reset column.

Checkmarks in the Software Deassert column denote reset signals that are left asserted by the reset manager. To activate the related modules, software can deassert these reset signals as needed by writing to the following reset manager registers:

- MPU module reset register (`mpumodrst`)
- Peripheral module reset register (`permodrst`)
- Peripheral 2 module reset register (`per2modrst`)
- Bridge module reset register (`brgmodrst`)

Table 3–3. Generated Module Resets (Part 1 of 3)

Group	Module Reset Signal	Description	Reset Domain	Cold Reset	Warm Reset	Debug Reset	Software Deassert
MPU	<code>mpu_cpu_rst_n[0]</code>	Resets each processor in the MPU	System	✓	✓		
	<code>mpu_cpu_rst_n[1]</code>	Resets each processor in the MPU	System	✓	✓		✓
	<code>mpu_wd_rst_n</code>	Resets both per-processor watchdogs in the MPU	System	✓	✓		
	<code>mpu_scu_periph_rst_n</code>	Resets Snoop Control Unit (SCU) and peripherals	System	✓	✓		
	<code>mpu_l2_rst_n</code>	Level 2 (L2) cache reset	System	✓	✓		

Table 3–3. Generated Module Resets (Part 2 of 3)

Group	Module Reset Signal	Description	Reset Domain	Cold Reset	Warm Reset	Debug Reset	Software Deassert
PER	emac_rst_n[1:0]	Resets each EMAC	System	✓	✓		✓
	usb_rst_n[1:0]	Resets each USB	System	✓	✓		✓
	nand_flash_rst_n	Resets NAND flash controller	System	✓	✓		✓
	qspi_flash_rst_n	Resets quad SPI flash controller	System	✓	✓		✓
	watchdog_rst_n[1:0]	Resets each system watchdog timer	System	✓	✓		✓
	oscl_timer_rst_n[1:0]	Resets each OSC1 timer	System	✓	✓		✓
	sp_timer_rst_n[1:0]	Resets each SP timer	System	✓	✓		✓
	i2c_rst_n[3:0]	Resets each I ² C controller	System	✓	✓		✓
	uart_rst_n[1:0]	Resets each UART	System	✓	✓		✓
	spim_rst_n[1:0]	Resets SPI master controller	System	✓	✓		✓
	spis_rst_n[1:0]	Resets SPI slave controller	System	✓	✓		✓
	sdmmc_rst_n	Resets SD/MMC controller	System	✓	✓		✓
	can_rst_n[1:0]	Resets each CAN controller	System	✓	✓		✓
	gpio_rst_n[2:0]	Resets each GPIO interface	System	✓	✓		✓
	dma_rst_n	Resets DMA controller	System	✓	✓		✓
	sdram_rst_n	Resets SDRAM subsystem (resets logic associated with cold or warm reset)	System	✓	✓		✓
PER2	dma_periph_if_rst_n[7:0]	DMA controller request interface from FPGA fabric to DMA controller	System	✓	✓		✓
Bridge	hps2fpga_bridge_rst_n	Resets HPS-to-FPGA AMBA [®] Advanced eXtensible Interface (AXI [™]) bridge	System	✓	✓		✓
	fpga2hps_bridge_rst_n	Resets FPGA-to-HPS AXI bridge	System	✓	✓		✓
	lwhps2fpga_bridge_rst_n	Resets lightweight HPS-to-FPGA AXI bridge	System	✓	✓		✓

Table 3–3. Generated Module Resets (Part 3 of 3)

Group	Module Reset Signal	Description	Reset Domain	Cold Reset	Warm Reset	Debug Reset	Software Deassert
MISC	boot_rom_rst_n	Resets boot ROM	System	✓	✓		
	onchip_ram_rst_n	Resets on-chip RAM	System	✓	✓		
	sys_manager_rst_n	Resets system manager (resets logic associated with cold or warm reset)	System	✓	✓		
	sys_manager_cold_rst_n	Resets system manager (resets logic associated with cold reset only)	System	✓			
	fpga_manager_rst_n	Resets FPGA manager	System	✓	✓		
	acp_id_mapper_rst_n	Resets ACP ID mapper	System	✓	✓		
	h2f_rst_n	Resets user logic in FPGA fabric (resets logic associated with cold or warm reset)	System	✓	✓		
	h2f_cold_rst_n	Resets user logic in FPGA fabric (resets logic associated with cold reset only)	System	✓			
	rst_pin_rst_n	Pulls nRST pin low	System	✓	✓		
	timestamp_cold_rst_n	Resets debug timestamp to 0x0	System	✓			
	clk_manager_cold_rst_n	Resets clock manager (resets logic associated with cold reset only)	System	✓			
	scan_manager_rst_n	Resets scan manager	System	✓	✓		
	frz_ctrl_cold_rst_n	Resets freeze controller (resets logic associated with cold reset only)	System	✓			
	sys_dbg_rst_n	Resets debug masters and slaves connected to L3 interconnect and level 4 (L4) buses	System	✓	✓		
	dbg_rst_n	Resets debug components including DAP, trace, MPU debug logic, and any user debug logic in the FPGA fabric	Debug	✓		✓	
	tap_cold_rst_n	Resets portion of TAP controller in the DAP that must be reset on a cold reset	TAP	✓			
	sdram_cold_rst_n	Resets SDRAM subsystem (resets logic associated with cold reset only)	System	✓			
L3	l3_rst_n	Resets L3 interconnect and L4 buses	System	✓	✓		

Slave Interface and Status Register

The reset manager slave interface is used to control and monitor the reset states.

The status register (stat) in the reset manager contains the status of the reset requester. The register contains a bit for each reset request. The stat register captures all reset requests that have occurred. Software is responsible for clearing the bits.

Functional Description of the Reset Manager

The reset manager generates reset signals to modules in the HPS and to the FPGA fabric. The following actions generate reset signals:

- Software writing a 1 to the `swcoldrstreq` or `swwarmrstreq` bits in the `ctrl` register. Writing either bit causes the reset controller to perform a reset sequence.
- Software writing to the `mpumodrst`, `permodrst`, `per2modrst`, `brgmodrst`, or `mismodrst` module reset control registers.
- Asserting reset request signals triggers the reset controller. All external reset requests cause the reset controller to perform a reset sequence.

 For information about the required duration of reset request signal assertion, refer to the *Cyclone V Device Datasheet*.

Multiple reset requests can be driven to the reset manager at the same time. Cold reset requests take priority over warm and debug reset requests. Higher priority reset requests preempt lower priority reset requests. There is no priority difference among reset requests within the same domain.

If a cold reset request is issued while another cold reset is already underway, the reset manager extends the reset period for all the module reset outputs until all cold reset requests are removed. If a cold reset request is issued while the reset manager is removing other modules out of the reset state, the reset manager returns those modules back to the reset state.


If a warm reset request is issued while another warm reset is already underway, the first warm reset completes before the second warm reset begins. If the second warm reset request is removed before the first warm reset completes, the warm first reset is extended to meet the timing requirements of the second warm reset request.

The `nPOR` pin can be used to extend the cold reset beyond what the POR voltage monitor automatically provides. The use of the `nPOR` pin is optional and can be tied high when it is not required.

Reset Sequencing

The reset controller sequences resets without software assistance. Module reset signals are asserted asynchronously at the same time. The reset manager deasserts the module reset signals synchronous to the `osc1_clk` clock. Module reset signals are deasserted in groups in a fixed sequence. All module reset signals in a group are deasserted at the same time.

The reset manager sends a safe mode request to the clock manager to put the clock manager in safe mode, which creates a fixed and known relationship between the `osc1_clk` clock and all other clocks generated by the clock manager.

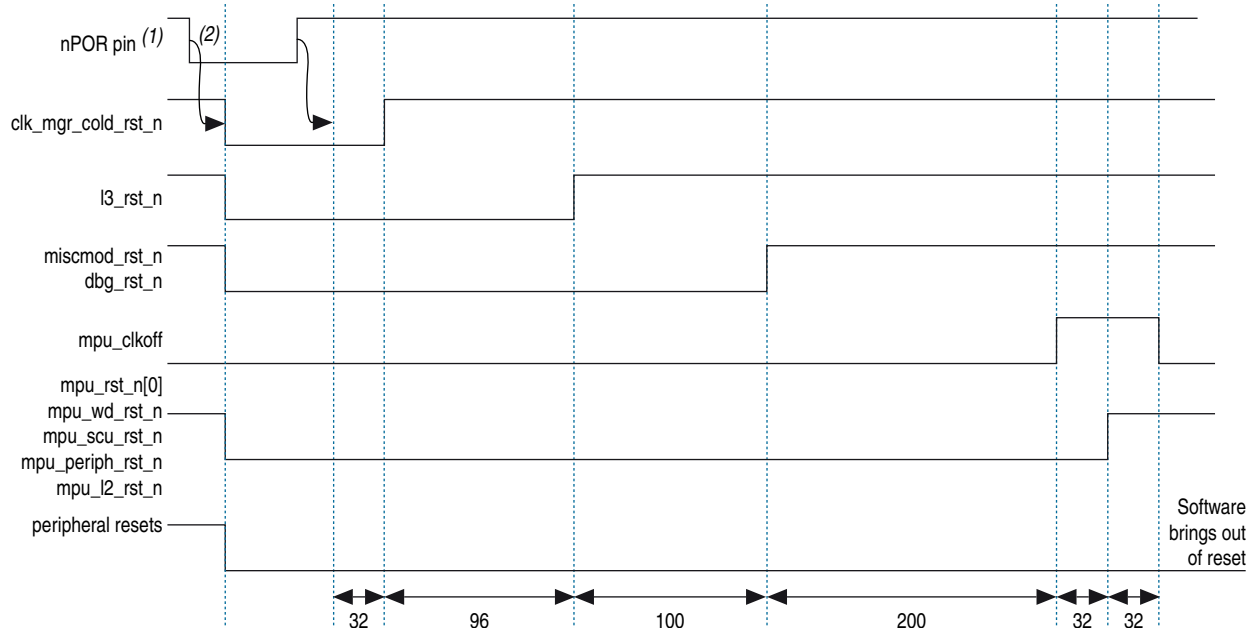
 For information about safe mode options, refer to the *Clock Manager* chapter in volume 3 of the *Cyclone V Device Handbook*.

After the reset manager releases the MPU subsystem from reset, CPU1 is left in reset and CPU0 begins executing code from the reset vector address. Software is responsible for deasserting CPU1 and other resets, as shown in [Table 3-3](#). Software deasserts resets by writing the `mpumodrst`, `permodrst`, `per2modrst`, `brgmodrst`, and `miscmodrst` module-reset control registers.

Software can also bypass the reset controller and generate reset signals directly through the module-reset control registers. In this case, software is responsible for asserting module reset signals, driving them for the appropriate duration, and deasserting them in the correct order. The clock manager is not typically in safe mode during this time, so software is responsible for knowing the relationship between the clocks generated by the clock manager. Software must not assert a module reset signal that would prevent software from deasserting the module reset signal. For example, software should not assert the module reset to the processor executing the software.

[Figure 3-3](#) shows the timing diagram for cold reset.

Figure 3-3. Cold Reset Timing Diagram

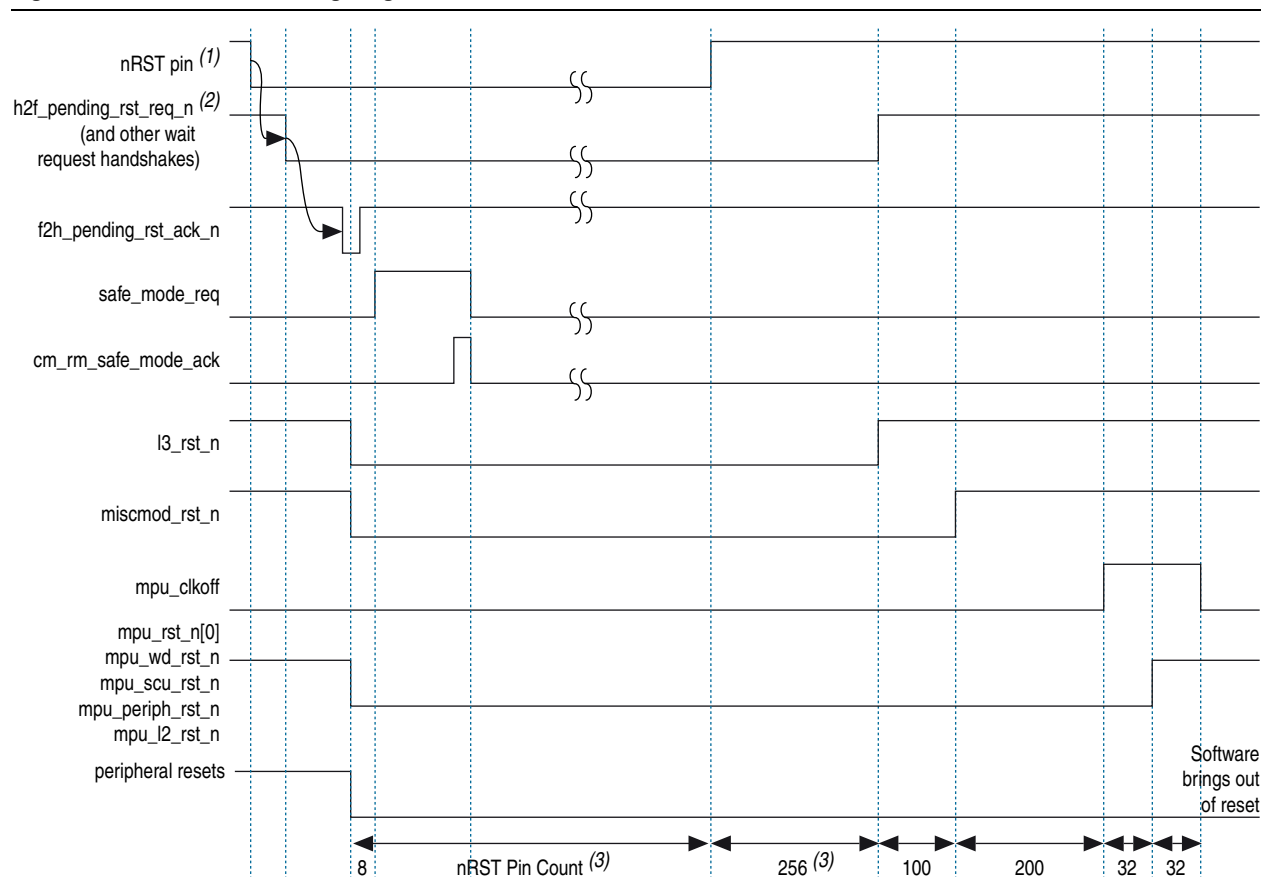


Note to Figure 3-3:

- (1) Cold reset can be initiated from several other sources. For the complete list, refer to [“Reset Controller” on page 3-3](#).
- (2) This dependency applies to all the reset signals.

Figure 3-4 shows the timing diagram for warm reset.

Figure 3-4. Warm Reset Timing Diagram



Notes to Figure 3-4:

- (1) Warm reset can be initiated from several other sources. For the complete list, refer to “Reset Controller” on page 3-3.
- (2) For information about the wait request reset handshaking, refer to “Reset Handshaking” on page 3-13.
- (3) When the nRST pin count is zero, the 256 cycle stretch count is skipped and the start of the deassertion sequence is determined by the safe mode acknowledge signal or the user releasing the warm reset button, whichever occurs later.

The cold and warm reset sequences consist of different reset assertion sequences and the same deassertion sequence. The following sections describe the sequences.

Cold Reset Assertion Sequence

The following list describes the assertion steps for cold reset shown in Figure 3-3:

1. Assert module resets.
2. Wait for 32 cycles. Deassert clock manager cold reset.
3. Wait for 96 cycles (so clocks can stabilize).
4. Proceed to the “Cold and Warm Reset Deassertion Sequence”.

Warm Reset Assertion Sequence

The following list describes the assertion steps for warm reset shown in Figure 3-4:

1. Optionally, handshake with the embedded trace router (ETR) and wait for acknowledge.
2. Optionally, handshake with the FPGA fabric and wait for acknowledge.
3. Optionally, handshake with the SDRAM controller, scan manager, and FPGA manager, and wait for acknowledges.
4. Assert module resets (except the MPU watchdog timer resets when the MPU watchdog timers are the only request sources).
5. Wait for 8 cycles and send a safe mode request to the clock manager.
6. Wait for the greater of the nRST pin count + 256 stretch count, or the warm reset counter, or the clock manager safe mode acknowledge, then deassert all handshakes except warm reset ETR handshake (which is deasserted by software).
7. Proceed to the **“Cold and Warm Reset Deassertion Sequence”**.

Cold and Warm Reset Deassertion Sequence

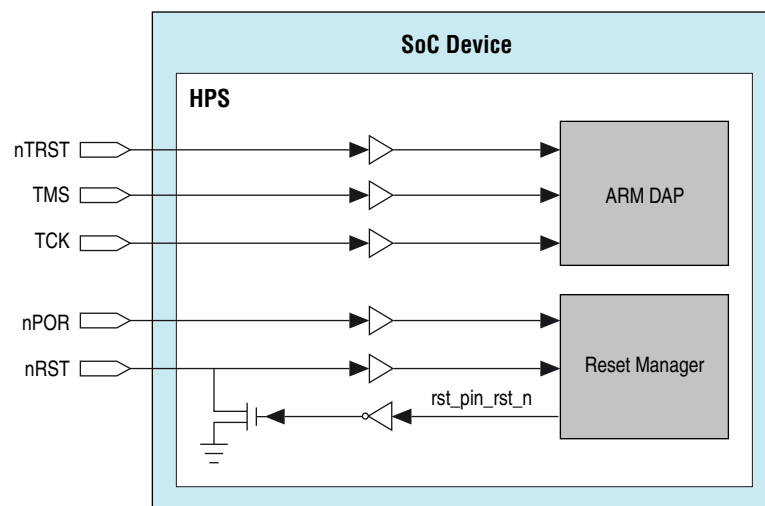
The following list describes the deassertion steps for both cold and warm reset shown in [Figure 3-3](#) and [Figure 3-4](#):

1. Deassert L3 reset.
2. Wait for 100 cycles. Deassert resets for miscellaneous-type and debug (cold only) modules.
3. Wait for 200 cycles. Assert mpu_clkoff for CPU0 and CPU1.
4. Wait for 32 cycles. Deassert resets for MPU modules.
5. Wait for 32 cycles. Deassert mpu_clkoff for CPU0 and CPU1.
6. Peripherals remain held in reset until software brings them out of reset.

Reset Pins

[Figure 3-5](#) shows all HPS pins related to reset.

Figure 3-5. Reset Pins



The test reset (`nTRST`), test mode select (`TMS`), and test clock (`TCK`) pins are associated with the TAP reset domain and are used to reset the TAP controller in the DAP. These pins are not connected to the reset manager.

The `nPOR` and `nRST` pins are used to request cold and warm resets respectively. The `nRST` pin is an open drain output as well. Any warm reset request causes the reset manager to drive the `rst_pin_rst_n` signal output low, which drives the `nRST` pin low. The amount of time the reset manager pulls `nRST` low is controlled by the `nRST` pin count field (`nrstcnt`) of the reset cycles count register (`counts`). This technique can be used to reset external devices (such as external memories) connected to the HPS.

Reset Effects

The following list describes how reset affects HPS logic:

- The TAP reset domain ignores warm reset.
- The debug reset domain ignores warm reset.
- System reset domain cold resets ignore warm reset.
- Each module defines reset behavior individually.



For more information, refer to the individual chapters in volume 3 of the *Cyclone V Device Handbook*.

Altering Warm Reset System Response

Registers in the clock manager, system manager, and reset manager control how warm reset affects the HPS. You can control the impact of a warm reset on the clocks and I/O elements.




Altera strongly recommends using Altera-provided libraries to configure and control this functionality.

The default warm reset behavior takes all clocks and I/O elements through a cold reset response. As your software becomes more stable or for debug purposes, you can alter the system response to a warm reset. The following suggestions provide ways to alter the system response to a warm reset. None of the register bits that control these items are affected by warm reset.

- Boot from on-chip RAM—enables warm boot from on-chip RAM instead of the boot ROM. When enabled, the boot ROM code validates the RAM code and jumps to it, making no changes to clocks or any other system settings prior to executing user code from on-chip RAM.
- Disable safe mode on warm reset—allows software to transition through a warm reset without affecting the clocks. Because the boot ROM code indirectly configures the clock settings after warm reset, Altera recommends to only disable safe mode when the HPS is not booting from a flash device.

- Disable safe mode on warm reset for the debug clocks—keeps the debug clocks from being affected by the assertion of safe mode request on a warm reset. This technique allows fast debug clocks, such as trace, to continue running through a warm reset. When enabled, the clock manager puts the debug clocks to their safe frequencies to respond to a safe mode request from the reset manager on a warm reset. Disable safe mode on warm reset for the debug clocks only when you are running the debug clocks off the main PLL VCO and you are certain the main PLL cannot be impacted by the event which caused the warm reset.
- Use the `osc1_clk` clock for debug control—keeps the debug base clock (main PLL C2 output) always bypassed to the `osc1_clk` external clock, independent of other clock manager settings. When implemented, disabling safe mode on warm reset for the debug clocks has no effect.

 For more information about safe mode, refer to the *Clock Manager* chapter in volume 3 of the *Cyclone V Device Handbook*.

Reset Handshaking


The reset manager participates in several reset handshaking protocols to ensure other modules are safely reset.

Before issuing a warm reset, the reset manager performs a handshake with several modules to allow them to prepare for a warm reset. The handshake logic ensures the following conditions:

- ETR master has no pending master transactions to the L3 interconnect
- Optionally preserve SDRAM contents during warm reset by issuing self-refresh mode request
- FPGA manager stops generating configuration clock
- Scan manager stops generating JTAG and I/O configuration clocks
- Warns the FPGA fabric of the forthcoming warm reset

Similarly, the handshake logic associated with ETR also occurs during the debug reset to ensure that the ETR master has no pending master transactions to the L3 interconnect before the debug reset is issued. This action ensures that when ETR undergoes a debug reset, the reset has no adverse effects on the system domain portion of the ETR.

Reset Manager Address Map and Register Definitions

 The address map and register definitions reside in the [hps.html](#) file that accompanies this handbook volume. Click the link to open the file.

To view the module description and base address, scroll to and click the link for any of the following module instances:

- **rstmgr**

To then view the register and field descriptions, scroll to and click the register names. The register addresses are offsets relative to the base address of each module instance.



The base addresses of all modules are also listed in the *Introduction to the Hard Processor System* chapter in volume 3 of the *Cyclone V Device Handbook*.

Document Revision History

Table 3-4 shows the revision history for this document.

Table 3-4. Document Revision History

Date	Version	Changes
November 2012	1.2	<ul style="list-style-type: none">■ Added cold and warm reset timing diagrams.■ Minor updates.
May 2012	1.1	Added reset controller, functional description, and address map and register definitions sections.
January 2012	1.0	Initial release.

This section includes the following chapters:

- [Chapter 4, Interconnect](#)
- [Chapter 5, HPS-FPGA AXI Bridges](#)



For information about the revision history for chapters in this section, refer to “Document Revision History” in each individual chapter.

The hard processor system (HPS) level 3 (L3) interconnect and level 4 (L4) peripheral buses are implemented with the ARM® CoreLink™ Network Interconnect (NIC-301). The NIC-301 provides a foundation for a high-performance HPS interconnect based on the ARM Advanced Microcontroller Bus Architecture (AMBA®) Advanced eXtensible Interface (AXI™), Advanced High-Performance Bus (AHB™), and Advanced Peripheral Bus (APB™) protocols. The L3 interconnect implements a multilayer, nonblocking architecture that supports multiple simultaneous transactions between masters and slaves, including the Cortex™-A9 microprocessor unit (MPU) subsystem. The interconnect provides five independent L4 buses to access control and status registers (CSRs) of peripherals, managers, and memory controllers



Additional information is available in the *AMBA Network Interconnect (NIC-301) Technical Reference Manual*, which you can download from the ARM website (infocenter.arm.com).

Features of the Interconnect

The L3 interconnect has the following characteristics:

- Main internal data width of 64 bits
- Programmable master priority with single-cycle arbitration
- Full pipelining to prevent master stalls
- Programmable control for FIFO buffer transaction release
- Security of the following types:
 - Secure
 - Nonsecure
 - Per transaction security
- Five independent L4 buses

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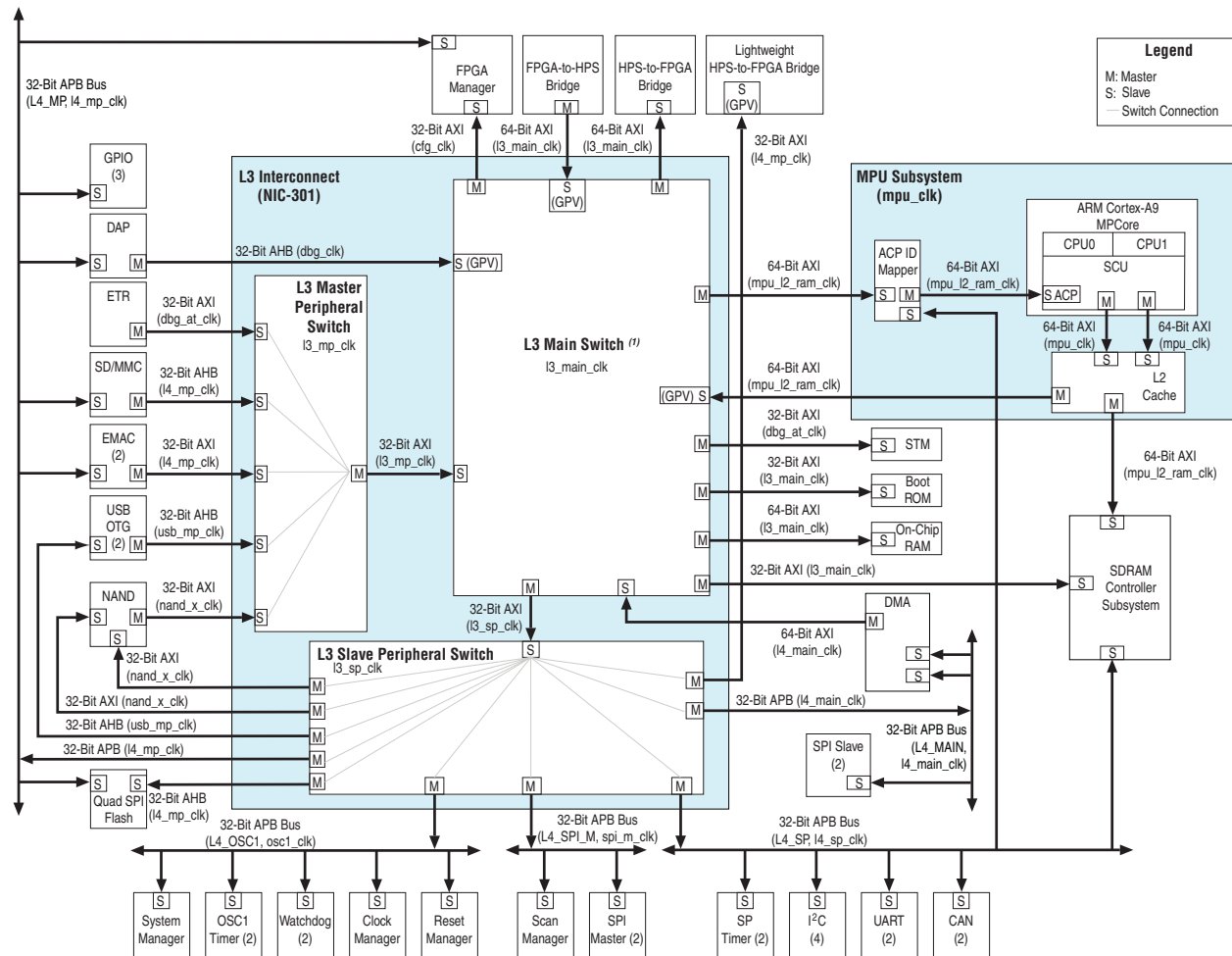
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Interconnect Block Diagram and System Integration

Figure 4-1 shows a block diagram of the L3 interconnect and L4 buses.

Figure 4-1. Interconnect Block Diagram



Note to Figure 4-1:

(1) For L3 main switch connection details, refer to Table 4-1.

The L3 interconnect is a partially-connected switch fabric; not all masters can access all slaves. For more information, refer to “Master-to-Slave Connectivity Matrix” on page 4-6.

Internally, the L3 interconnect is partitioned into the following subswitches:

- L3 main switch
 - Main switch used to transfer high-throughput 64-bit data
 - Operates at up to half the MPU main clock frequency
 - Provides masters with low-latency connectivity to AXI bridges, on-chip memories, SDRAM, and FPGA manager

- L3 master peripheral switch
 - Used to connect memory-mastering peripherals to the main switch
 - 32-bit data width
 - Operates at up to half the main switch clock frequency
- L3 slave peripheral switch
 - Used to provide access to level 3 and 4 slave interfaces for masters of the master peripheral and main switches
 - 32-bit data width
 - Five independent L4 buses

The L3 master and slave peripheral switches are fully-connected crossbars. The L3 main switch is a partially-connected crossbar. Table 4–1 shows the connectivity matrix of all the master and slave interfaces of the L3 main switch. Checkmarks denote connections.

Table 4–1. L3 Main Switch Connectivity Matrix

Masters	Slaves							
	L3 Slave Peripheral Switch	FPGA Manager	HPS-to-FPGA Bridge	ACP ID Mapper Data	STM	Boot ROM	On-Chip RAM	SDRAM Controller Subsystem L3 Data
L3 Master Peripheral Switch			✓	✓			✓	✓
L2 Cache Master 0	✓	✓	✓		✓	✓	✓	
FPGA-to-HPS Bridge	✓			✓	✓		✓	✓
DMA	✓	✓	✓	✓	✓		✓	✓
DAP	✓	✓	✓	✓			✓	✓

L3 Masters

The following list contains all of the master interfaces connected to the L3 interconnect:

- MPU subsystem—L2 cache master 0 connected to the L3 main switch
- FPGA-to-HPS bridge—Connected to the L3 main switch
- DMA—Connected to the L3 main switch
- EMAC0—Connected to the L3 master peripheral switch
- EMAC1—Connected to the L3 master peripheral switch
- USB0—Connected to the L3 master peripheral switch
- USB1—Connected to the L3 master peripheral switch
- NAND—Connected to the L3 master peripheral switch
- SD/MMC—Connected to the L3 master peripheral switch

- ETR—Connected to the L3 master peripheral switch
- DAP—Connected to the L3 main switch

L3 Slaves

The following list contains all of the slave interfaces connected to the L3 interconnect:

- USB0—CSR slave interface connected to the L3 slave peripheral switch
- USB1—CSR slave interface connected to the L3 slave peripheral switch
- NAND registers—CSR slave interface connected to the L3 slave peripheral switch
- NAND data—Command and data slave interface connected to the L3 slave peripheral switch
- Quad SPI flash—Data slave interface connected to the L3 slave peripheral switch
- FPGA manager—Data slave interface connected to the L3 main switch
- HPS-to-FPGA bridge—Data slave interface connected to the L3 main switch
- Lightweight HPS-to-FPGA bridge—Data slave interface connected to the L3 slave peripheral switch
- ACP ID mapper—Data slave interface connected to the L3 main switch
- STM—Connected to the L3 main switch
- Boot ROM—Connected to the L3 main switch
- On-chip RAM—Connected to the L3 main switch
- SDRAM controller subsystem—SDRAM multi-port front end slave interface connected to the L3 main switch

L4 Slaves

Each of the L4 slaves is an APB slave connected to one of the five following L4 buses:

- L4 slave peripheral (SP) bus—APB for peripherals that do not require fast access
 - SDRAM controller subsystem—CSR access
 - SP timer 0—CSR access
 - SP timer 1—CSR access
 - I2C0—CSR access
 - I2C1—CSR access
 - I2C2 (associated with EMAC0)—CSR access
 - I2C3 (associated with EMAC1)—CSR access
 - UART0—CSR access
 - UART1—CSR access
 - CAN0—CSR access
 - CAN1—CSR access

- L4 master peripheral (MP) bus—APB that provides access to primarily the L3 master peripherals.
 - ACP ID mapper—CSR access
 - FPGA manager—CSR access
 - DAP—CSR access
 - Quad SPI flash—CSR access
 - SD/MMC—CSR access
 - EMAC0—CSR access
 - EMAC1—CSR access
 - GPIO0—CSR access
 - GPIO1—CSR access
 - GPIO2—CSR access
- L4 oscillator 1 (OSC1) bus—APB dedicated to peripherals that operate on the external oscillator 1 domain.
 - OSC1 timer 0—CSR access
 - OSC1 timer 1—CSR access
 - Watchdog 0—CSR access
 - Watchdog 1—CSR access
 - Clock manager—CSR access
 - Reset manager—CSR access
 - System manager—CSR access
- L4 main bus—APB dedicated to the DMA and SPI slaves
 - DMA_s—Access to the DMA controllers secure registers
 - DMA_ns—Nonsecure access to the DMA controller nonsecure registers
 - SPI slave 0—CSR access
 - SPI slave 1—CSR access
- L4 SPI master (SPIM) bus—APB dedicated to the SPI masters and scan manager.
 - SPI master 0—CSR access
 - SPI master 1—CSR access
 - Scan manager—CSR access

Functional Description of the Interconnect

This section provides a functional description of the interconnect.

Master-to-Slave Connectivity Matrix

The interconnect is a partially-connected crossbar. Table 4–2 shows the connectivity matrix of all the master and slave interfaces of the interconnect. Checkmarks denote connections.

Table 4–2. Interconnect Connectivity Matrix

Masters	Slaves															
	L4 SP Bus Slaves	L4 MP Bus Slaves	L4 OSC1 Bus Slaves	L4 MAIN Bus Slaves	L4 SPIM Bus Slaves	Lightweight HPS-to-FPGA Bridge	USB OTG 0/1 CSR	NAND CSR	NAND Command and Data	Quad SPI Flash Data	FPGA Manager	HPS-to-FPGA Bridge	ACP ID Mapper Data	STM	Boot ROM	On-Chip RAM
L2 Cache Master 0	✓	✓	✓	✓	✓	✓	✓	✓	✓	✓	✓	✓		✓	✓	✓
FPGA-to-HPS Bridge	✓	✓	✓	✓	✓	✓	✓	✓	✓	✓			✓	✓		✓
DMA	✓	✓	✓	✓	✓	✓	✓	✓	✓	✓	✓	✓	✓	✓		✓
EMAC 0/1												✓	✓			✓
USB OTG 0/1												✓	✓			✓
NAND												✓	✓			✓
SD/MMC												✓	✓			✓
ETR												✓				✓
DAP	✓	✓	✓	✓	✓	✓	✓	✓	✓	✓	✓	✓	✓			✓

Address Remapping

The interconnect supports address remapping through the remap register. Remapping allows software to control which memory device (SDRAM, on-chip RAM, or boot ROM) is accessible at address 0x0 and the accessibility of the HPS-to-FPGA and lightweight HPS-to-FPGA bridges. The remap register is one of the NIC-301 Global Programmers View (GPV) registers and maps into the address space of the following L3 masters:

- MPU
- FPGA-to-HPS bridge
- DAP

The remapping bits in the remap register are not mutually exclusive. The lowest order remap bit has higher priority when multiple slaves are remapped to the same address. Each bit allows different combinations of address maps to be formed. There is only one remapping register available in the GPV, so modifying the remap register affects all memory maps of all the masters of the interconnect.

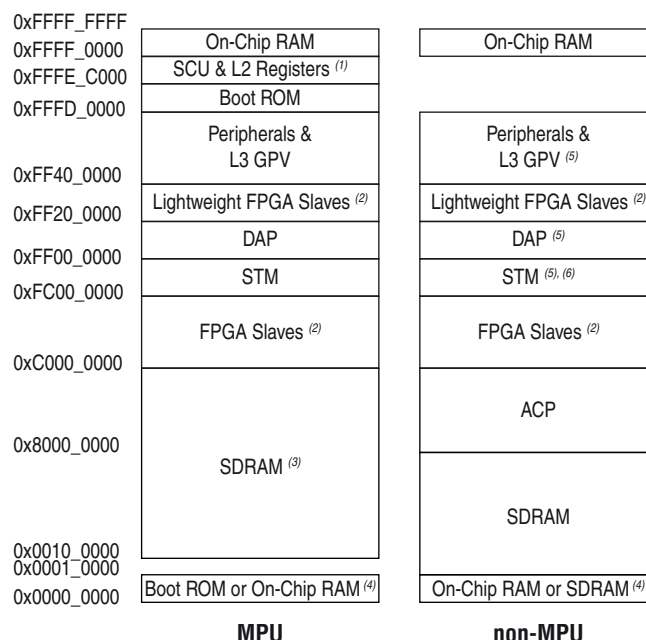
The effects of the remap bits can be categorized in the following groups:

- MPU master interface
 - L2 cache master 0 interface

- Non-MPU master interfaces
 - DMA master interface
 - Master peripheral interfaces
 - Debug Access Port (DAP) master interface
 - FPGA-to-HPS bridge master interface

Figure 4–2 shows the interconnect address map for all MPU and non-MPU masters. The figure is not to scale.

Figure 4–2. Address Map per Master



Notes to Figure 4–2:

- (1) The SCU and L2 cache registers are located in the MPU subsystem and are not accessible from the L3 interconnect.
- (2) This address range is not always accessible. For more information, refer to [Table 4–3](#).
- (3) The MPU subsystem has one master that connects to the interconnect and another master that connects directly to the SDRAM controller subsystem. The address filter registers in the MPU L2 control which MPU addresses are sent to each master. This figure assumes the filter registers contain their reset values.
- (4) This address range is configurable. For more information, refer to [Table 4–3](#).
- (5) This address range is not accessible from the master peripheral interfaces. For more information, refer to “[Master-to-Slave Connectivity Matrix](#)” on page 4–6.
- (6) This address range is not accessible from the DAP interface. For more information, refer to “[Master-to-Slave Connectivity Matrix](#)” on page 4–6.

For the MPU L3 master, either the boot ROM or on-chip RAM maps to address 0x0 and obscures the lowest 64 K of SDRAM. The address space from 0x0001_0000 to 0x0010_0000 is not accessible because the MPU L2 filter registers only have a granularity of 1 MB. After booting completes, the MPU can change address filtering to use the lowest 1 MB of SDRAM.

For non-MPU masters, either the on-chip RAM or the SDRAM maps to address 0x0. When mapped to address 0x0, the on-chip RAM obscures the lowest 64 K of SDRAM for non-MPU masters.

Table 4–3 lists how the remap bits affect the memory maps.

Table 4–3. Memory Map Remap Bits

Bit Name	Bit Offset	Description
mpuzero	0	When set to 0, the boot ROM maps to address 0x0 for the MPU L3 master. When set to 1, the on-chip RAM maps to address 0x0 for the MPU L3 master. This bit has no effect on non-MPU masters. Note that regardless of this setting, the boot ROM also always maps to address 0xfffd_0000 and the on-chip RAM also always maps to address 0xffff_0000 for the MPU L3 master.
nonmpuzero	1	When set to 0, the SDRAM maps to address 0x0 for the non-MPU L3 masters. When set to 1, the on-chip RAM maps to address 0x0 for the non-MPU masters. This bit has no effect on the MPU L3 master. Note that regardless of this setting, the on-chip RAM also always maps to address 0xffff_0000 for the non-MPU L3 masters.
Reserved	2	Must always be set to 0.
hps2fpga	3	When set to 1, the HPS-to-FPGA bridge slave port is visible to the L3 masters. When set to 0, accesses to the associated address range return an AXI decode error to the master.
lwhp2fpga	4	When set to 1, the lightweight HPS-to-FPGA bridge slave port is visible to the L3 masters. When set to 0, accesses to the associated address range return an AXI decode error to the master.
Reserved	31:5	Must always be set to 0.



L2 filter registers in the MPU subsystem, not the interconnect, allow the SDRAM to be remapped to address 0 for the MPU. For more information about the MPU subsystem, refer to the *Cortex-A9 MPU System* chapter in volume 3 of the *Cyclone V Device Handbook*.

Master Caching and Buffering Overrides

Some of the masters of the interconnect do not have the ability to drive the caching and buffering signals of their AXI and AHB interfaces. In order to ensure that these masters can perform transfers efficiently, the registers are available from the system manager so that you can enable cacheable and bufferable transactions. The following masters have their caching and buffering signals driven by the system manager:

- EMAC0 and EMAC1
- USB OTG 0 and USB OTG 1
- NAND flash
- SD/MMC

At reset time, the system manager drives the cache and buffering signals for these masters low. In other words, the masters listed do not support cacheable or bufferable accesses until you enable them after reset. There is no synchronization between the system manager and the interconnect, so avoid changing these settings when any of the masters are active. For more information about enabling or disabling this feature, refer to the *System Manager* chapter in volume 3 of the *Cyclone V Device Handbook*.

Security

Slave Security

The interconnect enforces security through the slave settings. The slave settings are controlled by the address region control registers accessible through the GPV registers. Each L3 and L4 slave has its own security check and programmable security settings. After reset, every slave of the interconnect is set to a secure state (referred to as boot secure). The only accesses allowed to secure slaves are by secure masters.

The GPV can only be accessed by secure masters. The security state of the interconnect is not accessible through the GPV as the security registers are write-only. Any nonsecure accesses to the GPV receive a DECERR response, and no register access is provided. Updates to the security settings through the GPV do not take effect until all transactions to the affected slave have completed.

Master Security

Masters of the interconnect are either secure, nonsecure, or the security is set on a per transaction basis. The DAP is capable of performing only secure accesses. The L2 cache master 0, FPGA-to-HPS-bridge, and DMA perform secure and nonsecure accesses on a per transaction basis. All other interconnect masters perform nonsecure accesses. For more information, refer to [“Interconnect Master Properties” on page 4–10](#).

Accesses to secure slaves by unsecure masters result in a response of DECERR and the transaction does not reach the slave.

Arbitration

At the entry point to the interconnect, all transactions are allocated a local quality of service (QoS) value that you can programmatically configure. The arbitration of the transaction throughout the infrastructure uses this QoS value. The QoS controls for each master connected to the interconnect are separated into read and write QoS priority values.

At any arbitration node, a fixed priority exists for transactions with different QoS values. The highest QoS value has the highest priority. If there are coincident transactions at an arbitration node with the same QoS value that require arbitration, then the interconnect uses a least recently used (LRU) algorithm.

Cyclic Dependency Avoidance Schemes

The AXI protocol permits re-ordering of transactions. As a result, when routing concurrent multiple transactions from a single point of divergence to multiple slaves, the interconnect might need to enforce rules to prevent deadlock.

Each master of the interconnect is configured with one of three possible cyclic dependency avoidance schemes (CDAS). The same CDAS scheme is configured for both read and write transactions, but they operate independently. The CDAS implementation for the masters is described in [“Interconnect Master Properties” on page 4–10](#).

The following schemes are available:

- Single Slave
- Single Slave Per ID
- Single Active Slave

Single Slave

Single slave (SS) ensures the following conditions at a slave interface of a switch:

- All outstanding read transactions are to a single end destination.
- All outstanding write transactions are to a single end destination.

If a master issues another transaction to a different destination than the current destination for that transaction type (read or write), the network stalls the transactions until all the outstanding transactions of that type have completed.

Single Slave Per ID

Single slave per ID (SSPID) ensures the following conditions at a slave interface of a switch:

- All outstanding read transactions with the same ID go the same destination.
- All outstanding write transactions with the same ID go the same destination.

When a master issues a transaction, the following situations can occur:

- If the transaction has an ID that does not match any outstanding transactions, it passes the CDAS.
- If the transaction has an ID that matches the ID of an outstanding transaction, and the destinations also match, it passes the CDAS.
- If the transaction has an ID that matches the ID of an outstanding transaction, and the destinations do not match, the transaction fails the CDAS check and stalls.

Single Active Slave

Single active slave (SAS) is the same as the SSPID scheme, with an added check for write transactions. SAS ensures that a master cannot issue a new write address until all of the data from the previous write transaction has been sent.

Interconnect Master Properties

The interconnect connects to various slave interfaces through the L3 main switch and L3 slave peripheral switch.

Table 4-4 shows all the master interfaces connected to the interconnect.

Table 4-4. Interconnect Master Interfaces (Part 1 of 2)

Master	Interface Width	Clock	Switch	Security	GPV Access	CDAS	Issuance ⁽¹⁾	Buffer Depth ⁽²⁾	Type
L2 cache M0	64	mpu_l2_ram_clk	L3 main switch	Per Transaction	Yes	SSPID	7, 12, 19	2, 2, 2, 2, 2	AXI
FPGA-to-HPS bridge	64	l3_main_clk	L3 main switch	Per Transaction	Yes	SAS	16, 16, 32	2, 2, 6, 6, 2	AXI

Table 4-4. Interconnect Master Interfaces (Part 2 of 2)

Master	Interface Width	Clock	Switch	Security	GPV Access	CDAS	Issuance ⁽¹⁾	Buffer Depth ⁽²⁾	Type
DMA	64	l4_main_clk	L3 main switch	Per Transaction	No	SSPID	8, 8, 8	2, 2, 2, 2, 2	AXI
EMAC 0/1	32	l4_main_clk	L3 master peripheral switch	Nonsecure	No	SSPID	16, 16, 32	2, 2, 2, 2, 2	AXI
USB OTG 0/1	32	usb_mp_clk	L3 master peripheral switch	Nonsecure	No	SSPID	2, 2, 4	2, 2, 2	AHB
NAND	32	nand_x_clk	L3 master peripheral switch	Nonsecure	No	SSPID	1, 8, 9	2, 2, 2, 2, 2	AXI
SD/MMC	32	l4_mp_clk	L3 master peripheral switch	Nonsecure	No	SSPID	2, 2, 4	2, 2, 2	AHB
ETR	32	dbg_at_clk	L3 master peripheral switch	Nonsecure	No	SSPID	32, 1, 32	2, 2, 2, 2, 2	AXI
DAP	32	dbg_clk	L3 main switch	Secure	Yes	SS	1, 1, 1	2, 2, 2	AHB

Notes to Table 4-4:

- (1) Issuance is based on the number of read, write, and total transactions.
- (2) The FIFO buffer depth for AXI is based on the AW, AR, R, W, and B channels. For AHB and APB, the depth is based on W, A, and D channels.

Interconnect Slave Properties

The interconnect connects to various slave interfaces through the L3 main switch, L3 slave peripheral switch, and the five L4 peripheral buses. After reset, all slave interfaces are set to the secure state.

Table 4-5 shows all the slave interfaces connected to the interconnect.

Table 4-5. Interconnect Slave Interfaces (Part 1 of 3)

Slave	Interface Width	Clock	Mastered By	Acceptance ⁽¹⁾	Buffer Depth ⁽²⁾	Interface Type
SDRAM subsystem CSR	32	l4_sp_clk	L4 SP bus master	1, 1, 1	2, 2, 2	APB
SP timer 0/1	32	l4_sp_clk	L4 SP bus master	1, 1, 1	2, 2, 2	APB
I ² C 0/1/2/3	32	l4_sp_clk	L4 SP bus master	1, 1, 1	2, 2, 2	APB
UART 0/1	32	l4_sp_clk	L4 SP bus master	1, 1, 1	2, 2, 2	APB
CAN 0/1	32	l4_sp_clk	L4 SP bus master	1, 1, 1	2, 2, 2	APB
GPIO 0/1/2	32	l4_mp_clk	L4 SP bus master	1, 1, 1	2, 2, 2	APB
ACP ID mapper CSR	32	l4_mp_clk	L4 SP bus master	1, 1, 1	2, 2, 2	APB
FPGA manager CSR	32	l4_mp_clk	L4 SP bus master	1, 1, 1	2, 2, 2	APB
DAP CSR	32	l4_mp_clk	L4 SP bus master	1, 1, 1	2, 2, 2	APB

Table 4-5. Interconnect Slave Interfaces (Part 2 of 3)

Slave	Interface Width	Clock	Mastered By	Acceptance ⁽¹⁾	Buffer Depth ⁽²⁾	Interface Type
Quad SPI flash CSR	32	l4_mp_clk	L4 SP bus master	1, 1, 1	2, 2, 2	APB
SD/MMC CSR	32	l4_mp_clk	L4 SP bus master	1, 1, 1	2, 2, 2	APB
EMAC 0/1 CSR	32	l4_mp_clk	L4 SP bus master	1, 1, 1	2, 2, 2	APB
System manager	32	osc1_clk	L4 OSC1 bus master	1, 1, 1	2, 2, 2	APB
OSC1 timer 0/1	32	osc1_clk	L4 OSC1 bus master	1, 1, 1	2, 2, 2	APB
Watchdog 0/1	32	osc1_clk	L4 OSC1 bus master	1, 1, 1	2, 2, 2	APB
Clock manager	32	osc1_clk	L4 OSC1 bus master	1, 1, 1	2, 2, 2	APB
Reset manager	32	osc1_clk	L4 OSC1 bus master	1, 1, 1	2, 2, 2	APB
DMA secure CSR	32	l4_main_clk	L4 main bus master	1, 1, 1	2, 2, 2	APB
DMA nonsecure CSR	32	l4_main_clk	L4 main bus master	1, 1, 1	2, 2, 2	APB
SPI slave 0/1	32	l4_main_clk	L4 main bus master	1, 1, 1	2, 2, 2	APB
Scan manager	32	spi_m_clk	L4 main bus master	1, 1, 1	2, 2, 2	APB
SPI master 0/1	32	spi_m_clk	L4 main bus master	1, 1, 1	2, 2, 2	APB
Lightweight HPS-to-FPGA bridge	32	l4_main_clk	L3 slave peripheral switch	16, 16, 32	2, 2, 2, 2, 2	AXI
USB OTG 0/1	32	usb_mp_clk	L3 slave peripheral switch	1, 1, 1	2, 2, 2	AHB
NAND CSR	32	nand_x_clk	L3 slave peripheral switch	1, 1, 1	2, 2, 2	AXI
NAND command and data	32	nand_x_clk	L3 slave peripheral switch	1, 1, 1	2, 2, 2	AXI
Quad SPI flash data	32	l4_mp_clk	L3 slave peripheral switch	1, 1, 1	2, 2, 2	AHB
FPGA manager data	32	cfg_clk	L3 main switch	1, 2, 3	2, 2, 2, 32, 2	AXI
HPS-to-FPGA bridge	64	l3_main_clk	L3 main switch	16, 16, 32	2, 2, 6, 6, 2	AXI
ACP ID mapper data	64	mpu_l2_ram_clk	L3 main switch	13, 5, 18	2, 2, 2, 2, 2	AXI
STM	32	dbg_at_clk	L3 main switch	1, 2, 2	2, 2, 2, 2, 2	AXI
On-chip boot ROM	32	l3_main_clk	L3 main switch	1, 1, 2	0, 0, 0, 0, 0	AXI
On-chip RAM	64	l3_main_clk	L3 main switch	2, 2, 2	0, 0, 0, 8, 0	AXI

Table 4-5. Interconnect Slave Interfaces (Part 3 of 3)

Slave	Interface Width	Clock	Mastered By	Acceptance ⁽¹⁾	Buffer Depth ⁽²⁾	Interface Type
SDRAM subsystem L3 data	32	l3_main_clk	L3 main switch	16, 16, 16	2, 2, 2, 2, 2	AXI
Notes to Table 4-5: (1) Acceptance is based on the number of read, write, and total transactions. (2) The FIFO buffer depth for AXI is based on the AW, AR, R, W, and B channels. For AHB and APB, the depth is based on the W, A, and D channels.						

Upsizing Data Width Function

The upsizing function combines narrow transactions into wider transactions to increase the overall system bandwidth. Upsizing only packs data for read or write transactions that are cacheable. If the interconnect splits input-exclusive transactions into more than one output bus transaction, it removes the exclusive information from the multiple transactions it creates.

The upsizing function can expand the data width by the following ratios:

- 1:2
- 1:4

If multiple responses from created transactions are combined into one response, then the following order of priority applies:

- DECERR is the highest priority
- SLVERR is the next highest priority
- OKAY is the lowest priority.



For more information about AXI terms such as DECERR, WRAP, and INCR, refer to the *AMBA AXI Protocol Specification v1.0*, which you can download from the ARM website (infocenter.arm.com).

Incrementing Bursts

The interconnect converts all input INCR bursts that complete within a single output data width to an INCR1 burst of the minimum SIZE possible, and packs all INCR bursts into INCR bursts of the optimal size possible for maximum data throughput.

Wrapping Bursts

All WRAP bursts are either passed through unconverted as WRAP bursts, or converted to one or two INCR bursts of the output bus. The interconnect converts input WRAP bursts that have a total payload less than the output data width to a single INCR burst.

Fixed Bursts

All FIXED bursts pass through unconverted.

Bypass Merge

If the programmable bit `bypass_merge` is enabled, the interconnect does not alter any transactions that could pass through legally without alteration. Bypass merge is accessible through the GPV registers and is only accessible to secure masters.

Downsizing Data Width Function

The downsizing function reduces the data width of a transaction to match the optimal data width at the destination. Downsizing does not merge multiple-transaction data narrower than the destination bus if the transactions are marked as noncacheable.

The downsizing function reduces the data width by the following ratios:

- 2:1
- 4:1

Incrementing Bursts

The interconnect converts INCR bursts that fall within the maximum payload size of the output data bus to a single INCR burst. It converts INCR bursts that are greater than the maximum payload size of the output data bus to multiple INCR bursts.

INCR bursts with a size that matches the output data width pass through unconverted.

The interconnect packs INCR bursts with a SIZE smaller than the output data width to match the output width whenever possible, using the upsizing function. For more information, refer to [“Upsizing Data Width Function” on page 4-13](#).

Wrapping Bursts

The interconnect always converts WRAP bursts to WRAP bursts of twice the length, up to the output data width maximum size of WRAP16, and treats the WRAP burst as two INCR bursts that can each be converted into one or more INCR bursts.

Fixed Bursts

The interconnect converts FIXED bursts to one or more INCR1 or INCRn bursts depending on the downsize ratio.


Bypass Merge

If the programmable bit `bypass_merge` is enabled, the interconnect does not perform any packing of beats to match the optimal SIZE for maximum throughput, up to the output data width SIZE. Bypass merge is accessible through the GPV registers and is only accessible to secure masters.

If an exclusive transaction is split into multiple transactions at the output of the downsizing function, the exclusive flag is removed and the master never receives an EXOKAY response. Response priority is the same as for the upsizing function, described in [“Upsizing Data Width Function” on page 4-13](#).

Lock Support

Lock is not supported by the interconnect. For atomic accesses, masters can perform exclusive accesses when sharing data located in the HPS SDRAM.

-  For more information about exclusive access support, refer to the *SDRAM Controller Subsystem* chapter in volume 3 of the *Cyclone V Device Handbook*.

FIFO Buffers and Clocks

The interconnect contains FIFO buffers in the majority of the interfaces exposed to the HPS master and slaves, as well as between the subswitches. These FIFO buffers also provide clock domain crossing for masters and slaves that operate at a different clock frequency than the switch they connect to.

Data Release Mechanism


For network ports containing write data FIFO buffers with a depth of four or greater, you can set a write tidemark function, `wr_tidemark`. This tidemark level stalls the release of the transaction until one of the following situations occurs:

- The interconnect receives the `WLAST` beat of a burst.
- The write data FIFO buffer becomes full.
- The number of occupied slots in the write data FIFO buffer exceeds the write tidemark.


For more information about which interfaces contain write data FIFO buffers with a depth of four or greater, refer to “*Interconnect Master Properties*” on page 4-10.

Resets

The interconnect has one reset signal. The reset manager drives this signal to the SD/MMC controller on a cold or warm reset. On reset, the boot ROM is mapped to address 0x0. The DAP virtually maps to ID 2.

-  For more information about resets, refer to the *Reset Manager* chapter in volume 3 of the *Cyclone V Device Handbook*. For information about virtual ID mapping by the ACP ID mapper, refer to the *Cortex-A9 MPU System* chapter in volume 3 of the *Cyclone V Device Handbook*.


Interconnect Address Map and Register Definitions

-  The address map and register definitions reside in the [hps.html](#) file that accompanies this handbook volume. Click the link to open the file.

To view the module description and base address, scroll to and click the link for the following module instance:

- **l3regs**

To then view the register and field descriptions, scroll to and click the register names. The register addresses are offsets relative to the base address of each module instance.

-  The base addresses of all modules are also listed in the *Introduction to the Hard Processor System* chapter in volume 3 of the *Cyclone V Device Handbook*.

Document Revision History

Table 4–6 shows the revision history for this document.

Table 4–6. Document Revision History

Date	Version	Changes
November 2012	1.2	Minor updates.
June 2012	1.1	<ul style="list-style-type: none">■ Added main switch connectivity matrix table.■ Rearranged functional description sections.■ Simplified address remapping section.■ Added address map and register definitions section.
January 2012	1.0	Initial release.

This chapter describes the bridges in the hard processor system (HPS) used to communicate data between the FPGA fabric and HPS logic. The bridges use the Advanced Microcontroller Bus Architecture (AMBA®) Advanced eXtensible Interface (AXI™) protocol, and are based on the AMBA Network Interconnect (NIC-301).



Additional information is available in the *AMBA AXI Protocol Specification v1.0* and the *AMBA Network Interconnect (NIC-301) Technical Reference Manual*, which you can download from the ARM website (infocenter.arm.com).

The HPS contains the following HPS-FPGA AXI bridges:

- **FPGA-to-HPS Bridge**
- **HPS-to-FPGA Bridge**
- **Lightweight HPS-to-FPGA Bridge**

Features of the AXI Bridges

The HPS-FPGA AXI bridges allow masters in the FPGA fabric to communicate with slaves in the HPS logic and vice versa. For example, you can instantiate additional memories or peripherals in the FPGA fabric, and master interfaces belonging to components in the HPS logic can access them. You can also instantiate components such as a Nios® II processor in the FPGA fabric and their master interfaces can access memories or peripherals in the HPS logic.

The AXI bridges provide the features listed in [Table 5-1](#).

Table 5-1. AXI Bridge Features

Feature	FPGA-to-HPS Bridge	HPS-to-FPGA Bridge	Lightweight HPS-to-FPGA Bridge
Supports the AMBA AXI3 interface protocol	✓	✓	✓
Implements clock crossing and manages the transfer of data across the clock domains in the HPS logic and the FPGA fabric	✓	✓	✓
Performs data width conversion between the HPS logic and the FPGA fabric	✓	✓	✓
Allows configuration of FPGA interface widths at instantiation time	✓	✓	

Each bridge consists of an AXI master-slave pair with one interface exposed to the FPGA fabric and the other exposed to the HPS logic. The HPS-to-FPGA and lightweight HPS-to-FPGA bridges expose an AXI master interface that you can connect to AXI or Avalon-MM slave interfaces in the FPGA fabric. The FPGA-to-HPS bridge exposes an AXI slave interface that you can connect to AXI master or Avalon-MM interfaces in the FPGA fabric.

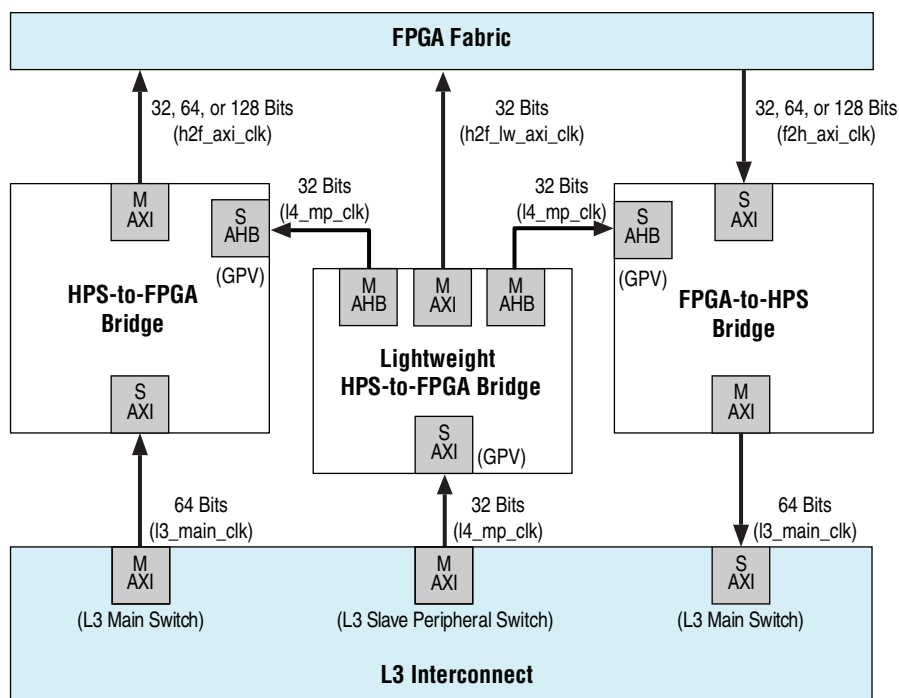


For information about configuring the AXI bridges, refer to the *Instantiating the HPS Component* chapter in volume 3 of the *Cyclone V Device Handbook*.

AXI Bridges Block Diagram and System Integration

Figure 5–1 shows a block diagram of the AXI bridges in the context of the FPGA fabric and the L3 interconnect to the HPS. Each master (M) and slave (S) interface is shown with its data width(s). The clock domain for each interconnect is shown in parentheses. The clock domains are described in “Clocks and Resets” on page 5–12.


Figure 5–1. AXI Bridge Connectivity



The HPS-to-FPGA bridge is mastered by the level 3 (L3) main switch and the lightweight HPS-to-FPGA bridge is mastered by the L3 slave peripheral switch.

The FPGA-to-HPS bridge masters the L3 main switch, allowing any master implemented in the FPGA fabric to access most slaves in the HPS. For example, the FPGA-to-HPS bridge can access the accelerator coherency port (ACP) of the Cortex-A9 MPU subsystem to perform cache-coherent accesses to the SDRAM subsystem.

All three bridges contain global programmers view (GPV) registers. The GPV registers control the behavior of the bridge. Access to the GPV registers of all three bridges is provided through the lightweight HPS-to-FPGA bridge.

 For more information about connectivity, such as which masters have access to each bridge, refer to the *Interconnect* chapter in volume 3 of the *Cyclone V Device Handbook*.

Functional Description of the AXI Bridges

The Global Programmers View

The HPS-to-FPGA bridge includes a set of registers called the GPV. The GPV provides settings to control the bridge properties and behavior. Access to the GPV registers of all three bridges is provided through the lightweight HPS-to-FPGA bridge.

The GPV registers can only be accessed by secure masters in the HPS or the FPGA fabric.

FPGA-to-HPS Bridge

The FPGA-to-HPS bridge provides access to the peripherals and memory in the HPS. This access is available to any master implemented in the FPGA fabric. You can configure the bridge slave, which is exposed to the FPGA fabric, to support 32-, 64-, or 128-bit data. The master interface of the bridge, connected to the L3 interconnect, has a data width of 64 bits.

Table 5–2 lists the properties of the FPGA-to-HPS bridge, including the configurable slave interface exposed to the FPGA fabric.

Table 5–2. FPGA-to-HPS Bridge Properties

Bridge Property	FPGA Slave Interface	L3 Master Interface
Data width ⁽¹⁾	32, 64, or 128 bits	64 bits
Clock domain	f2h_axi_clk	l3_main_clk
Byte address width	32 bits	32 bits
ID width	8 bits	8 bits
Read acceptance	16 transactions	16 transactions
Write acceptance	16 transactions	16 transactions
Total acceptance	32 transactions	32 transactions
Note to Table 5–2:		
(1) The bridge slave data width is user-configurable at the time you instantiate the HPS component in your system.		

The FPGA-to-HPS bridge contains a GPV, described in “*The Global Programmers View*”. The GPV registers provide settings that adjust the bridge slave properties when the FPGA slave interface is configured to be 32 or 128 bits wide. The slave issuing capability can be adjusted, through the `fn_mod` register, to allow one or multiple transactions to be outstanding in the HPS. The slave bypass merge feature can also be enabled, through the `bypass_merge` bit in the `fn_mod2` register. This feature ensures that the upsizing and downsizing logic does not alter any transactions when the FPGA slave interface is configured to be 32 or 128 bits wide.



It is critical to provide the correct `14_mp_clk` clock to support access to the GPV, as described in “GPV Clocks” on page 5-13.

FPGA-to-HPS Access to ACP

When the error correction code (ECC) option is enabled in the level 2 (L2) cache controller, all accesses from the FPGA-to-HPS bridge to the ACP must be 64 bits wide and aligned on 8-byte boundaries after up- or downsizing takes place.

Table 5-3 lists some possible master and FPGA-to-HPS bridge slave configurations that support accesses to the L2 cache with ECC enabled.

Table 5-3. FPGA Master and FPGA-to-HPS Bridge Configurations

Soft Logic Master Width	Soft Logic Master Alignment	Soft Logic Master Burst Size (Width)	Soft Logic Master Burst Length	FPGA-to-HPS Bridge Slave Width
32 bits	8 bytes	4 bytes	2, 4, 6, 8, 10, 12, 14, or 16 beats	32 bits
64 bits	8 bytes	8 bytes	1 to 16 beats	32 bits
128 bits	8 or 16 bytes	8 or 16 bytes	1 to 16 beats	32 bits
32 bits	8 bytes	4 bytes	2, 4, 6, 8, 10, 12, 14, or 16 beats	64 bits
64 bits	8 bytes	8 bytes	1 to 16 beats	64 bits
128 bits	8 or 16 bytes	8 or 16 bytes	1 to 16 beats	64 bits
32 bits	8 bytes	4 bytes	2, 4, 6, 8, 10, 12, 14, or 16 beats	128 bits
64 bits	8 bytes	8 bytes	1 to 16 beats	128 bits
128 bits	8 or 16 bytes	8 or 16 bytes	1 to 16 beats	128 bits



For more information about the ECC option of the L2 cache, refer to the *Cortex-A9 Microprocessor Unit Subsystem* chapter in volume 3 of the *Cyclone V Device Handbook*.

FPGA-to-HPS Bridge Slave Signals

The FPGA-to-HPS bridge slave address channels support user-sideband signals, routed to the ACP in the MPU subsystem. All the signals have a fixed width except the data and write strobes for the read and write data channels. The variable width signals depend on the data width setting of the bridge. Table 5-4 through Table 5-8 list all the signals exposed by the FPGA-to-HPS slave interface to the FPGA fabric.

Table 5-4 lists the slave write address channel signals.

Table 5-4. FPGA-to-HPS Bridge Slave Write Address Channel Signals

Signal	Width	Direction	Description
AWID	8 bits	Input	Write address ID
AWADDR	32 bits	Input	Write address
AWLEN	4 bits	Input	Burst length
AWSIZE	3 bits	Input	Burst size
AWBURST	2 bits	Input	Burst type
AWLOCK	2 bits	Input	Lock type—Valid values are 00 (normal access) and 01 (exclusive access)
AWCACHE	4 bits	Input	Cache policy type
AWPROT	3 bits	Input	Protection type

Table 5-4. FPGA-to-HPS Bridge Slave Write Address Channel Signals

Signal	Width	Direction	Description
AWVALID	1 bit	Input	Write address channel valid
AWREADY	1 bit	Output	Write address channel ready
AWUSER	5 bits	Input	User sideband signals

Table 5-5 lists the slave write data channel signals.

Table 5-5. FPGA-to-HPS Bridge Slave Write Data Channel Signals

Signal	Width	Direction	Description
WID	8 bits	Input	Write ID
WDATA	32, 64, or 128 bits	Input	Write data
WSTRB	4, 8, or 16 bits	Input	Write data strobes
WLAST	1 bit	Input	Write last data identifier
WVALID	1 bit	Input	Write data channel valid
WREADY	1 bit	Output	Write data channel ready

Table 5-6 lists the slave write response channel signals.

Table 5-6. FPGA-to-HPS Bridge Slave Write Response Channel Signals

Signal	Width	Direction	Description
BID	8 bits	Output	Write response ID
BRESP	2 bits	Output	Write response
BVALID	1 bit	Output	Write response channel valid
BREADY	1 bit	Input	Write response channel ready

Table 5-7 lists the slave read address channel signals.

Table 5-7. FPGA-to-HPS Bridge Slave Read Address Channel Signals

Signal	Width	Direction	Description
ARID	8 bits	Input	Read address ID
ARADDR	32 bits	Input	Read address
ARLEN	4 bits	Input	Burst length
ARSIZE	3 bits	Input	Burst size
ARBURST	2 bits	Input	Burst type
ARLOCK	2 bits	Input	Lock type—Valid values are 00 (normal access) and 01 (exclusive access)
ARCACHE	4 bits	Input	Cache policy type
ARPROT	3 bits	Input	Protection type
ARVALID	1 bit	Input	Read address channel valid
ARREADY	1 bit	Output	Read address channel ready
ARUSER	5 bits	Input	Read user sideband signals

Table 5–8 lists the slave read data channel signals.

Table 5–8. FPGA-to-HPS Bridge Slave Read Data Channel Signals

Signal	Width	Direction	Description
RID	8 bits	Output	Read ID
RDATA	32, 64, or 128 bits	Output	Read data
RRESP	2 bits	Output	Read response
RLAST	1 bit	Output	Read last data identifier
RVALID	1 bit	Output	Read data channel valid
RREADY	1 bit	Input	Read data channel ready

HPS-to-FPGA Bridge

The HPS-to-FPGA bridge provides a configurable-width, high-performance master interface to the FPGA fabric. The bridge provides most masters in the HPS with access to logic, peripherals, and memory implemented in the FPGA. The effective size of the address space is 0x3FFF0000, or 1 gigabyte (GB) minus 64 megabytes (MB). The address space size is less than 1 GB because 64 MB is occupied by peripherals, lightweight HPS-to-FPGA bridge, on-chip RAM, and boot ROM in the HPS. You can configure the bridge master exposed to the FPGA fabric for 32-, 64-, or 128-bit data. The amount of address space exposed to the MPU subsystem can also be reduced through the L2 cache address filtering mechanism.



For detailed information about which masters have access to each bridge, refer to the *Interconnect* chapter in volume 3 of the *Cyclone V Device Handbook*. For details about L2 cache address filtering, refer to the *Cortex-A9 Microprocessor Unit Subsystem* chapter in volume 3 of the *Cyclone V Device Handbook*.

The slave interface of the bridge in the HPS logic has a data width of 64 bits. The bridge provides width adaptation and clock crossing logic that allows the logic in the FPGA to operate in any clock domain, asynchronous from the HPS.



The HPS-to-FPGA bridge is accessed if the MPU boots from the FPGA. Before the MPU boots from the FPGA, the FPGA portion of the SoC device must be configured, and the HPS-to-FPGA bridge must be remapped into addressable space.



For more information about enabling the HPS-to-FPGA bridge, refer to the *Interconnect* chapter in volume 3 of the *Cyclone V Device Handbook*.

Table 5-9 lists the properties of the HPS-to-FPGA bridge, including the configurable master interface exposed to the FPGA fabric.

Table 5-9. HPS-to-FPGA Bridge Properties

Bridge Property	L3 Slave Interface	FPGA Master Interface
Data width ⁽¹⁾	64 bits	32, 64, or 128 bits
Clock domain	l3_main_clk	h2f_axi_clk
Byte address width	32 bits	30 bits
ID width	12 bits	12 bits
Read acceptance	16 transactions	16 transactions
Write acceptance	16 transactions	16 transactions
Total acceptance	32 transactions	32 transactions
Note to Table 5-9:		
(1) The bridge master data width is user-configurable at the time you instantiate the HPS component in your system.		

The HPS-to-FPGA bridge's GPV, described in "The Global Programmers View" on page 5-3, provides settings to adjust the bridge master properties. The master issuing capability can be adjusted, through the `fn_mod` register, to allow one or multiple transactions to be outstanding in the FPGA fabric. The master bypass merge feature can also be enabled, through the `bypass_merge` bit in the `fn_mod2` register. This feature ensures that the upsizing and downsizing logic does not alter any transactions when the FPGA master interface is configured to be 32 or 128 bits wide.



It is critical to provide the correct `l4_mp_clk` clock to support access to the GPV, as described in "GPV Clocks" on page 5-13.

HPS-to-FPGA Bridge Master Signals

All the HPS-to-FPGA bridge master signals have a fixed width except the data and write strobes for the read and write data channels. The variable-width signals depend on the data width setting of the bridge interface exposed to the FPGA logic. Table 5-10 through Table 5-14 list all the signals exposed by the HPS-to-FPGA master interface to the FPGA fabric.

Table 5–10 lists the master write address channel signals.

Table 5–10. HPS-to-FPGA Bridge Master Write Address Channel Signals

Signal	Width	Direction	Description
AWID	12 bits	Output	Write address ID
AWADDR	30 bits	Output	Write address
AWLEN	4 bits	Output	Burst length
AWSIZE	3 bits	Output	Burst size
AWBURST	2 bits	Output	Burst type
AWLOCK	2 bits	Output	Lock type—Valid values are 00 (normal access) and 01 (exclusive access)
AWCACHE	4 bits	Output	Cache policy type
AWPROT	3 bits	Output	Protection type
AWVALID	1 bit	Output	Write address channel valid
AWREADY	1 bit	Input	Write address channel ready

Table 5–11 lists the master write data channel signals.

Table 5–11. HPS-to-FPGA Bridge Master Write Data Channel Signals

Signal	Width	Direction	Description
WID	12 bits	Output	Write ID
WDATA	32, 64, or 128 bits	Output	Write data
WSTRB	4, 8, or 16 bits	Output	Write data strobes
WLAST	1 bit	Output	Write last data identifier
WVALID	1 bit	Output	Write data channel valid
WREADY	1 bit	Input	Write data channel ready

Table 5–12 lists the master write response channel signals.

Table 5–12. HPS-to-FPGA Bridge Master Write Response Channel Signals

Signal	Width	Direction	Description
BID	12 bits	Input	Write response ID
BRESP	2 bits	Input	Write response
BVALID	1 bit	Input	Write response channel valid
BREADY	1 bit	Output	Write response channel ready

Table 5-13 lists the master read address channel signals.

Table 5-13. HPS-to-FPGA Bridge Master Read Address Channel Signals

Signal	Width	Direction	Description
ARID	12 bits	Output	Read address ID
ARADDR	30 bits	Output	Read address
ARLEN	4 bits	Output	Burst length
ARSIZE	3 bits	Output	Burst size
ARBURST	2 bits	Output	Burst type
ARLOCK	2 bits	Output	Lock type—Valid values are 00 (normal access) and 01 (exclusive access)
ARCACHE	4 bits	Output	Cache policy type
ARPROT	3 bits	Output	Protection type
ARVALID	1 bit	Output	Read address channel valid
ARREADY	1 bit	Input	Read address channel ready

Table 5-14 lists the master read data channel signals.

Table 5-14. HPS-to-FPGA Bridge Master Read Data Channel Signals

Signal	Width	Direction	Description
RID	12 bits	Input	Read ID
RDATA	32, 64, or 128 bits	Input	Read data
RRESP	2 bits	Input	Read response
RLAST	1 bit	Input	Read last data identifier
RVALID	1 bit	Input	Read data channel valid
RREADY	1 bit	Output	Read data channel ready

Lightweight HPS-to-FPGA Bridge

The lightweight HPS-to-FPGA bridge provides a lower-performance interface to the FPGA fabric. This interface is useful for accessing the control and status registers of soft peripherals. The bridge provides a 2 MB address space and access to logic, peripherals, and memory implemented in the FPGA fabric. The MPU subsystem, direct memory access (DMA) controller, and debug access port (DAP) can use the lightweight HPS-to-FPGA bridge to access the FPGA fabric or GPV. Master interfaces in the FPGA fabric can also use the lightweight HPS-to-FPGA bridge to access the GPV registers in all three bridges.



For detailed information about which masters have access to each bridge, refer to the *Interconnect* chapter in volume 3 of the *Cyclone V Device Handbook*.

The bridge master exposed to the FPGA fabric has a fixed data width of 32 bits. The slave interface of the bridge in the HPS logic has a fixed data width of 32 bits.

Use the lightweight HPS-to-FPGA bridge as a secondary, lower-performance master interface to the FPGA fabric. With a fixed width and a smaller address space, the lightweight bridge is useful for low-bandwidth traffic, such as memory-mapped register accesses to FPGA peripherals. This approach diverts traffic from the high-performance HPS-to-FPGA bridge, and can improve both CSR access latency and overall system performance.

Table 5-15 lists the properties of the lightweight HPS-to-FPGA bridge, including the master interface exposed to the FPGA fabric.

Table 5-15. Lightweight HPS-to-FPGA Bridge Properties

Bridge Property	L3 Slave Interface	FPGA Master Interface
Data width	32 bits	32 bits
Clock domain	l4_mp_clk	h2f_lw_axi_clk
Byte address width	32 bits	21 bits
ID width	12 bits	12 bits
Read acceptance	16 transactions	16 transactions
Write acceptance	16 transactions	16 transactions
Total acceptance	32 transactions	32 transactions

The lightweight HPS-to-FPGA bridge has three master interfaces, as shown in Figure 5-1 on page 5-2. The master interface connected to the FPGA fabric provides a lightweight interface from the HPS to custom logic in the FPGA fabric. The two other master interfaces, connected to the HPS-to-FPGA and FPGA-to-HPS bridges, allow you to access the GPV registers for each bridge.

The lightweight HPS-to-FPGA bridge also has a GPV to control the behavior of its four interfaces (one slave and three masters). The GPV is described in “The Global Programmers View” on page 5-3.

The GPV allows you to set the bridge’s issuing capabilities to support single or multiple transactions. The GPV also lets you set a write tidemark through the `wr_tidemark` register, to control how much data is buffered in the bridge before data is written to slaves in the FPGA fabric.



It is critical to provide correct clock settings for the lightweight HPS-to-FPGA bridge, even if your design does not use this bridge. The `l4_mp_clk` clock is required for GPV access on the HPS-to-FPGA and FPGA-to-HPS bridges.

Lightweight HPS-to-FPGA Bridge Master Signals

All the lightweight HPS-to-FPGA bridge master signals have a fixed width. Table 5-16 through Table 5-20 list all the signals exposed by the lightweight HPS-to-FPGA master interface to the FPGA fabric.

Table 5-16 lists the master write address channel signals.

Table 5-16. Lightweight HPS-to-FPGA Bridge Master Write Address Channel Signals

Signal	Width	Direction	Description
AWID	12 bits	Output	Write address ID
AWADDR	21 bits	Output	Write address
AWLEN	4 bits	Output	Burst length
AWSIZE	3 bits	Output	Burst size
AWBURST	2 bits	Output	Burst type
AWLOCK	2 bits	Output	Lock type—Valid values are 00 (normal access) and 01 (exclusive access)
AWCACHE	4 bits	Output	Cache policy type
AWPROT	3 bits	Output	Protection type
AWVALID	1 bit	Output	Write address channel valid
AWREADY	1 bit	Input	Write address channel ready

Table 5-17 lists the master write data channel signals.

Table 5-17. Lightweight HPS-to-FPGA Bridge Master Write Data Channel Signals

Signal	Width	Direction	Description
WID	12 bits	Output	Write ID
WDATA	32 bits	Output	Write data
WSTRB	4 bits	Output	Write data strobes
WLAST	1 bit	Output	Write last data identifier
WVALID	1 bit	Output	Write data channel valid
WREADY	1 bit	Input	Write data channel ready

Table 5-18 lists the master write response channel signals.

Table 5-18. Lightweight HPS-to-FPGA Bridge Master Write Response Channel Signals

Signal	Width	Direction	Description
BID	12 bits	Input	Write response ID
BRESP	2 bits	Input	Write response
BVALID	1 bit	Input	Write response channel valid
BREADY	1 bit	Output	Write response channel ready

Table 5–19 lists the master read address channel signals.

Table 5–19. Lightweight HPS-to-FPGA Bridge Master Read Address Channel Signals

Signal	Width	Direction	Description
ARID	12 bits	Output	Read address ID
ARADDR	21 bits	Output	Read address
ARLEN	4 bits	Output	Burst length
ARSIZE	3 bits	Output	Burst size
ARBURST	2 bits	Output	Burst type
ARLOCK	2 bits	Output	Lock type—Valid values are 00 (normal access) and 01 (exclusive access)
ARCACHE	4 bits	Output	Cache policy type
ARPROT	3 bits	Output	Protection type
ARVALID	1 bit	Output	Read address channel valid
ARREADY	1 bit	Input	Read address channel ready

Table 5–20 lists the master read data channel signals.

Table 5–20. Lightweight HPS-to-FPGA Bridge Master Read Data Channel Signals

Signal	Width	Direction	Description
RID	12 bits	Input	Read ID
RDATA	32 bits	Input	Read data
RRESP	2 bits	Input	Read response
RLAST	1 bit	Input	Read last data identifier
RVALID	1 bit	Input	Read data channel valid
RREADY	1 bit	Output	Read data channel ready

Clocks and Resets

FPGA-to-HPS Bridge

The master interface of the bridge in the HPS logic operates in the `l3_main_clk` clock domain. The slave interface exposed to the FPGA fabric operates in the `f2h_axi_clk` clock domain provided by the user logic. The bridge provides clock crossing logic that allows the logic in the FPGA to operate in any clock domain, asynchronous from the HPS.



For information about the `f2h_axi_clk` clock, refer to the *HPS Component Interfaces* chapter in volume 3 of the *Cyclone V Device Handbook*. For information about the `l3_main_clk` and `l4_mp_clk` clocks, refer to the *Clock Manager* chapter in volume 3 of the *Cyclone V Device Handbook*.


The FPGA-to-HPS bridge has one reset signal, `fpga2hps_bridge_rst_n`. The reset manager drives this signal to FPGA-to-HPS bridge on a cold or warm reset.



For more information about the reset manager, refer to the *Reset Manager* chapter in volume 3 of the *Cyclone V Device Handbook*.

HPS-to-FPGA Bridge

The master interface into the FPGA fabric operates in the `h2f_axi_clk` clock domain. The `h2f_axi_clk` clock is provided by user logic. The slave interface of the bridge in the HPS logic operates in the `l3_main_clk` clock domain. The bridge provides clock crossing logic that allows the logic in the FPGA to operate in any clock domain, asynchronous from the HPS.


 For information about the `l3_main_clk` clock, refer to the [Clock Manager](#) chapter in volume 3 of the *Cyclone V Device Handbook*. For information about the `h2f_axi_clk` clock, refer to the [HPS Component Interfaces](#) chapter in volume 3 of the *Cyclone V Device Handbook*.

The HPS-to-FPGA bridge has one reset signal, `hps2fpga_bridge_rst_n`. The reset manager drives this signal to HPS-to-FPGA bridge on a cold or warm reset.


For more information about the reset manager, refer to the [Reset Manager](#) chapter in volume 3 of the *Cyclone V Device Handbook*.

Lightweight HPS-to-FPGA Bridge

The master interface into the FPGA fabric operates in the `h2f_lw_axi_clk` clock domain provided by custom logic in the FPGA fabric. The slave interface of the bridge in the HPS logic operates in the `l4_mp_clk` clock domain. The bridge provides clock crossing logic that allows the logic in the FPGA to operate in any clock domain, asynchronous from the HPS.

 For information about the `l4_mp_clk` clock, refer to the [Clock Manager](#) chapter in volume 3 of the *Cyclone V Device Handbook*. For information about the `h2f_lw_axi_clk` clock, refer to the [HPS Component Interfaces](#) chapter in volume 3 of the *Cyclone V Device Handbook*.

The lightweight HPS-to-FPGA bridge has one reset signal, `lwhps2fpga_bridge_rst_n`. The reset manager drives this signal to the lightweight HPS-to-FPGA bridge on a cold or warm reset.

 For more information about the reset manager, refer to the [Reset Manager](#) chapter in volume 3 of the *Cyclone V Device Handbook*.

GPV Clocks

The FPGA-to-HPS and HPS-to-FPGA bridges have GPV slave interfaces, mastered by the lightweight HPS-to-FPGA bridge. These interfaces operate in the `l4_mp_clk` clock domain. Even if you do not use the lightweight HPS-to-FPGA bridge in your FPGA design, you must ensure that a valid `l4_mp_clk` clock is being generated, so that the GPV registers in the HPS-to-FPGA and FPGA-to-HPS bridges can be programmed. The GPV logic in all three bridges is in the `l4_mp_clk` domain. For information about the GPV, refer to [“The Global Programmers View” on page 5-3](#).

Data Width Sizing

The HPS-to-FPGA and FPGA-to-HPS bridges allow 32-, 64-, and 128-bit interfaces to be exposed to the FPGA fabric. For 32-bit and 128-bit interfaces, the bridge performs data width conversion to the fixed 64-bit interface within the HPS. This conversion is called *upsizing* in the case of data being converted from a 64-bit interface to a 128-bit interface. It is called *downsizing* in the case of data being converted from a 64-bit interface to a 32-bit interface. If an exclusive access is split into multiple transactions, the transactions lose their exclusive access information.

During the upsizing or downsizing process, transactions can also be resized using a data merging technique. For example, in the case of a 32-bit to 64-bit upsizing, if the size of each beat entering the bridge's 32-bit interface is only two bytes, the bridge can merge up to four beats to form a single 64-bit beat. Similarly, in the case of a 128-bit to 64-bit downsizing, if the size of each beat entering the bridge's 128-bit interface is only four bytes, the bridge can merge two beats to form a single 64-bit beat.

The bridges do not perform transaction merging for accesses marked as noncacheable.



You can set the `bypass_merge` bit in the GPV to prevent the bridge from merging data and responses. If the bridge merges multiple responses into a single response, that response is the one with the highest priority. The response types have the following priorities:

1. DECERR
2. SLVERR
3. OKAY

HPS-FPGA AXI Bridges Address Map and Register Definitions



The address map and register definitions reside in the [hps.html](#) file that accompanies this handbook volume. Click the link to open the file.

To view the module description and base address, scroll to and click the following links for the module instance:

- [fpga2hpsregs](#)
- [hps2fpgaregs](#)

To then view the register and field descriptions, scroll to and click the register names. The register addresses are offsets relative to the base address of each module instance.



The base addresses of all modules are also listed in the [Introduction to the Hard Processor](#) chapter in volume 3 of the *Cyclone V Device Handbook*.

Document Revision History

Table 5-21 lists the revision history for this document.

Table 5-21. Document Revision History

Date	Version	Changes
November 2012	1.1	Described GPV.
January 2012	1.0	Initial release.

This section includes the following chapters:

- [Chapter 6, Cortex-A9 Microprocessor Unit Subsystem](#)



For information about the revision history for chapters in this section, refer to “Document Revision History” in each individual chapter.

The hard processor system (HPS) in the Altera® SoC FPGA device includes a stand-alone, full-featured ARM® Cortex™-A9 MPCore™, single- or dual-core 32-bit application processor. The Cortex-A9 MPU subsystem is composed of a Cortex-A9 MPCore, a level 2 (L2) cache, an Accelerator Coherency Port (ACP) ID mapper, and debugging modules.

Features of the Cortex-A9 MPU Subsystem

The Altera Cortex-A9 MPU subsystem provides the following features:

- One or two Cortex-A9 processors
- Interrupt controller
- Private interval and watchdog timer for each processor
- Global timer
- TrustZone® system security extensions
- Symmetric multiprocessing (SMP) and asymmetric multiprocessing (AMP) modes
- Debugging modules

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Cortex-A9 MPU Subsystem Block Diagram and System Integration

Figure 6–1 shows a dual-core MPU subsystem in the context of the HPS, with the L2 cache. The L2 cache can access either the level 3 (L3) interconnect fabric or the SDRAM.

Figure 6–1. Cortex-A9 MPU Subsystem with L3 Interconnect

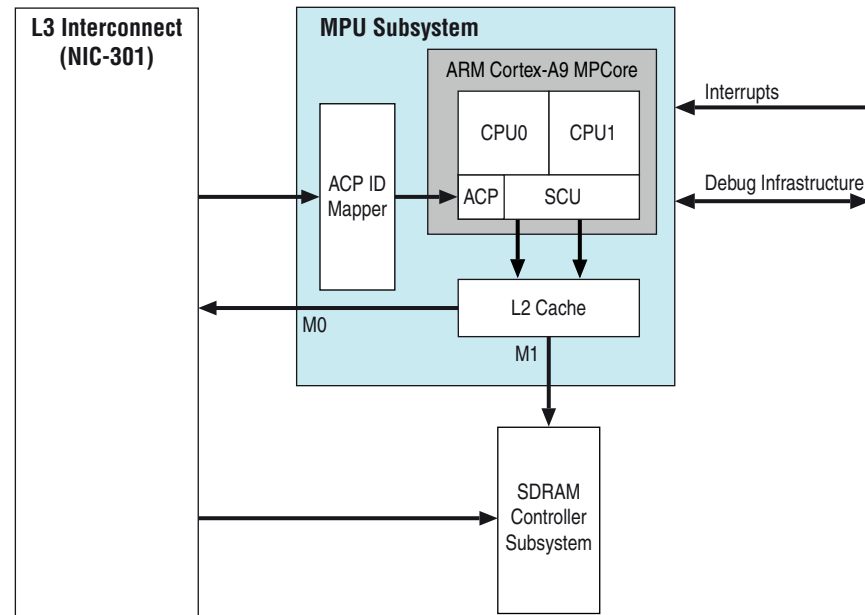
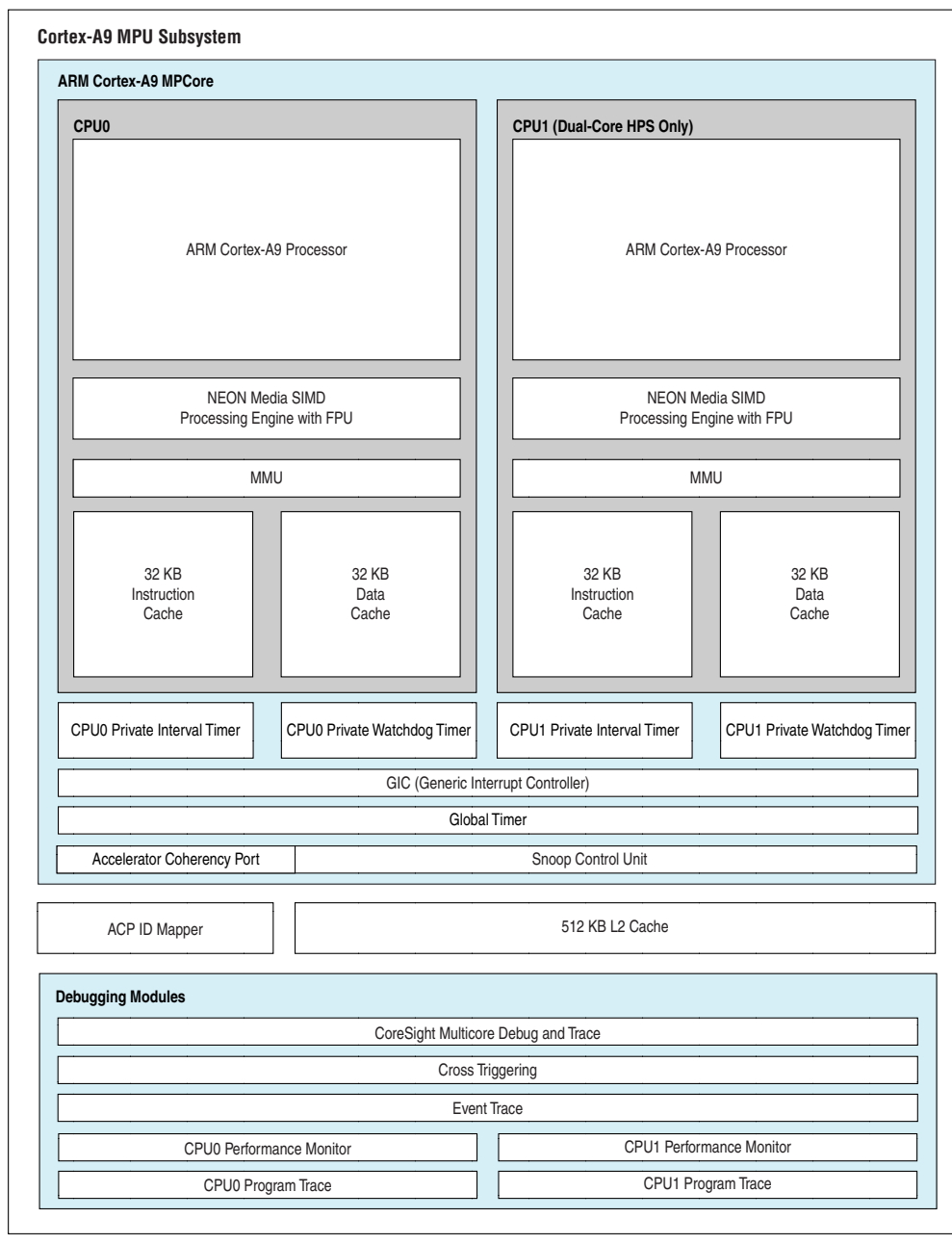


Figure 6–2 shows a block diagram of the Altera Cortex-A9 MPU subsystem.

Figure 6–2. Cortex-A9 MPU Subsystem Internals



Cortex-A9 MPU Subsystem Components

The Altera Cortex-A9 MPU subsystem consists of the following hardware blocks:

- ARM Cortex-A9 MPCore
- ARM L2C-310 L2 cache controller

- ACP ID mapper
- Debugging and trace features

This section describes the components of the Cortex-A9 MPU subsystem.

Cortex-A9 MPCore

The MPU subsystem includes a stand-alone, full-featured ARM Cortex-A9 MPCore single- or dual-core 32-bit application processor. The processor, like other HPS masters, can access IP in the FPGA fabric using through the HPS-to-FPGA bridges.

Functional Description

The ARM Cortex-A9 MPCore contains the following blocks:

- One or two Cortex-A9 Revision r3p0 processors operating in SMP or AMP mode
- Snoop control unit (SCU)
- Private interval timer for each processor core
- Private watchdog timer for each processor core
- Global timer
- Interrupt controller

Each transaction originating from the Altera Cortex-A9 MPU subsystem can be flagged as secure or nonsecure.

Implementation Details

Table 6–1 shows the parameter settings for the Altera Cortex-A9 MPCore.

Table 6–1. Cortex-A9 MPCore Processor Configuration

Feature	Options
Cortex-A9 processors	1 or 2
Instruction cache size per Cortex-A9 processor	32 KB
Data cache size per Cortex-A9 processor	32 KB
TLB size per Cortex-A9 processor	128 entries
Media Processing Engine with NEON™ technology per Cortex-A9 processor ⁽¹⁾	Included
Preload Engine per Cortex-A9 processor	Included
Number of entries in the Preload Engine FIFO per Cortex-A9 processor	16
Jazelle DBX extension per Cortex-A9 processor	Full
PTM interface per Cortex-A9 processor	Included
Support for parity error detection ⁽²⁾	Included
ARM_BIST	Included
Master ports	Two
Accelerator Coherency Port	Included
Notes to Table 6–1: (1) Includes support for floating-point operations. (2) For a description of the parity error scheme and parity error signals, Refer to the Cortex-A9 Technical Reference Manual, Revision r3p0, available on the ARM website (infocenter.arm.com).	



For further information about Cortex-A9 MPCore configurable options, refer to the *Introduction* chapter of the *Cortex-A9 MPCore Technical Reference Manual*, Revision r3p0, available on the ARM website (infocenter.arm.com).

Cortex-A9 Processor

Each Cortex-A9 processor includes the following hardware blocks:

- ARM NEON™ single instruction, multiple data (SIMD) coprocessor with vector floating-point (VFP) v3 double-precision floating point unit for media and signal processing acceleration
 - Single- and double-precision IEEE-754 floating point math support
 - Integer and polynomial math support
- Level 1 (L1) cache with parity checking
 - 32 KB four-way set-associative instruction cache
 - 32 KB four-way set-associative data cache
- CoreSight™ Program Trace Macrocell (PTM) supporting instruction trace

Each Cortex-A9 processor supports the following features:

- Dual-issue superscalar pipeline with advanced branch prediction
- Out-of-order (OoO) dispatch and speculative instruction execution

- 2.5 million instructions per second (MIPS) per MHz, based on the Dhrystone 2.1 benchmark
- 128-entry translation lookaside buffer (TLB)
- TrustZone security extensions
- Configurable data endianness
- Jazelle® DBX Extensions for byte-code dynamic compiler support
- The Cortex-A9 processor architecture supports the following instruction sets:
 - The ARMv7-A performance-optimized instruction set
 - The memory-optimized Thumb®-2 mixed instruction set
 - Improves energy efficiency
 - 31% smaller memory footprint
 - 38% faster than the original Thumb instruction set
 - The Thumb instruction set—supported for legacy applications
- Each processor core in the Altera HPS includes a memory management unit (MMU) to support the memory management requirements of common modern operating systems.

The Cortex-A9 processors are designated CPU0 and CPU1.


 Detailed documentation of ARM Cortex-A9 series processors, Revision r3p0, is available on the ARM website (infocenter.arm.com).

Interactive Debugging Features

Each Cortex-A9 processor has built-in debugging capabilities, including the following features:

- Six hardware breakpoints, including two with Context ID comparison capability
- Four watchpoints

The interactive debugging features can be controlled by external JTAG tools or by processor-based monitor code.

 For more information about the interactive debugging system, refer to the *Debug* chapter of the *Cortex-A9 Technical Reference Manual*, Revision r3p0, available on the ARM website (infocenter.arm.com).

L1 Caches

Cache memory that is closely coupled with an associated processor is called level 1, or L1 cache. Each Cortex-A9 processor has two independent 32 KB L1 caches—one for instructions and one for data—allowing simultaneous instruction fetches and data access.

Each L1 cache is four-way set associative, with 32 bytes per line, and supports parity checking.

Preload Engine

The preload engine (PLE) is a hardware block that enables the L2 cache to preload selected regions of memory. The PLE signals the L2 cache when a cache line will be needed in the L2 cache, by making the processor data master port start fetching the data. The processor data master does not complete the fetch or return the data to the processor. However, the L2 cache can then proceed to load the cache line. The data is only loaded to the L2 cache, not to the L1 cache or processor registers.

The preload functionality is under software control. The following PLE control parameters must be programmed:

- Programmed parameters, including the following:
 - Base address
 - Length of stride
 - Number of blocks
- A valid bit
- TrustZone memory protection for the cache memory, with an NS (non-secure) state bit
- A translation table base (TTB) address
- An Address Space Identifier (ASID) value



For more information about the PLE, refer to the *Preload Engine* chapter of the *Cortex-A9 Technical Reference Manual*, Revision r3p0, available on the ARM website (infocenter.arm.com).

Floating Point Unit

Each ARM Cortex-A9 processor includes full support for IEEE-754 floating point operations. The floating-point unit (FPU) fully supports half-, single-, and double-precision variants of the following operations:

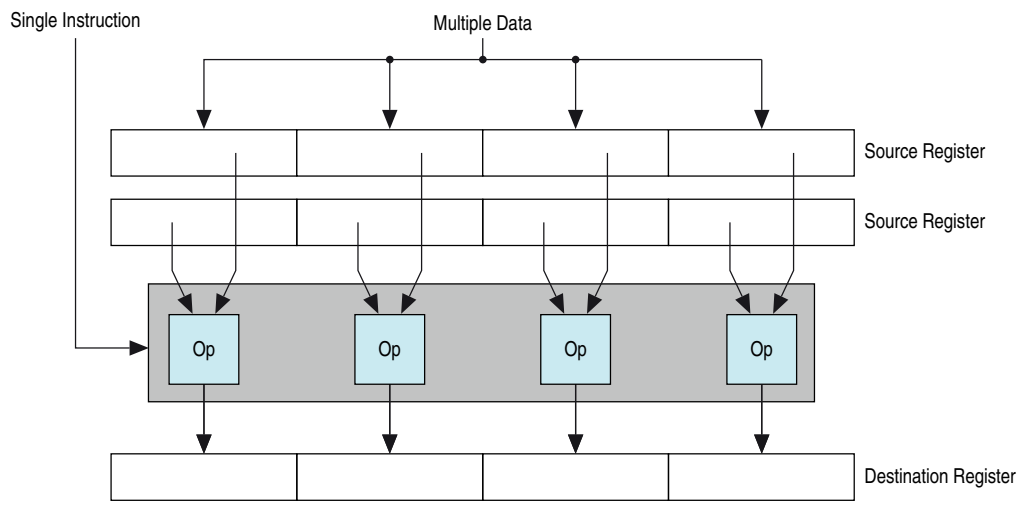
- Add
- Subtract
- Multiply
- Divide
- Multiply and accumulate (MAC)
- Square root

The FPU also converts between floating-point data formats and integers, including special operations to round towards zero required by high-level languages.

NEON Multimedia Processing Engine

The NEON multimedia processing engine (MPE) provides hardware acceleration for media and signal processing applications. Each ARM Cortex-A9 processor includes an ARM NEON MPE that supports SIMD processing, as shown in Figure 6-3. The NEON processing engine accelerates multimedia and signal processing algorithms such as video encoding and decoding, 2-D and 3-D graphics, audio and speech processing, image processing, telephony, and sound synthesis.

Figure 6-3. Single Instruction, Multiple Data (SIMD) Processing



The Cortex-A9 NEON MPE performs the following types of operations:

- SIMD and scalar single-precision floating-point computations
- Scalar double-precision floating-point computation
- SIMD and scalar half-precision floating-point conversion
- 8-bit, 16-bit, 32-bit, and 64-bit signed and unsigned integer SIMD computation
- 8-bit or 16-bit polynomial computation for single-bit coefficients

The following operations are available:

- Addition and subtraction
- Multiplication with optional accumulation (MAC)
- Maximum or minimum value driven lane selection operations
- Inverse square root approximation
- Comprehensive data-structure load instructions, including register-bank-resident table lookup



For more information about the Cortex-A9 NEON MPE, refer to the *Cortex-A9 NEON™ Media Processing Engine Technical Reference Manual*, Revision r3p0, which you can download from the ARM website (infocenter.arm.com).

Memory Management Unit

The MMU is used in conjunction with the L1 and L2 caches to translate virtual addresses used by software to physical addresses used by hardware. Each processor has a private MMU.

The MMU supports the TLBs shown in [Table 6-2](#).

Table 6-2. Supported TLBs

TLB Type	Memory Type	Number of Entries	Associativity
Micro TLB	Instruction	32	Fully associative
Micro TLB	Data	32	Fully associative
Main TLB	Instruction and Data	128	Two-way associative

The main TLB has the following features:

- Lockable entries using the lock-by-entry model
- Supports hardware page table walks to perform look-ups in the L1 data cache



For more information about the MMU, refer to the *Memory Management Unit* chapter of the *Cortex-A9 Technical Reference Manual*, Revision r3p0, available on the ARM website (infocenter.arm.com).

The MPU address map is divided into the following regions:

- The boot region
- The SDRAM region
- The FPGA slaves region
- The HPS peripherals region

This section describes the location and contents of each region.

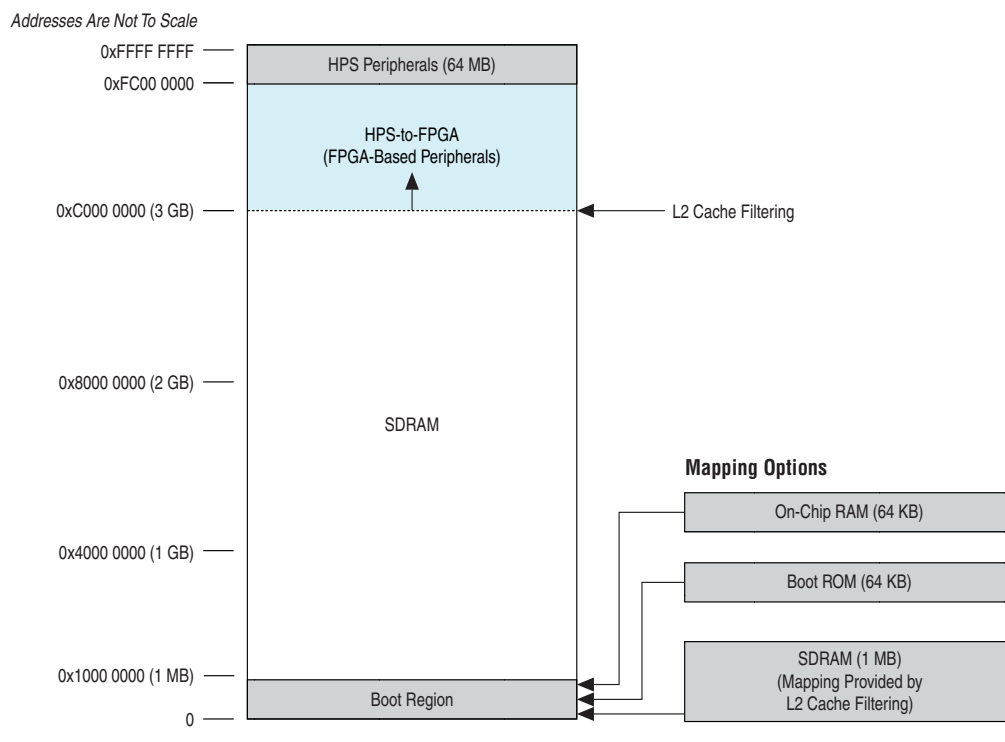
The Boot Region

The boot region is 1 MB in size, based at address 0. After power-on, or after reset of the L3 interconnect, the boot region is occupied by the boot ROM, allowing the Cortex-A9 MPCore to boot. Although the boot region size is 1 MB, accesses beyond 64 KB are illegal because the boot ROM is only 64 KB.

As shown in [Figure 6-4](#), this 1 MB region can be subsequently remapped to the bottom 1 MB of SDRAM. For more information, refer to [“The SDRAM Region”](#).



Alternatively, the boot region can be mapped to the 64 KB on-chip RAM. For more information, refer to the [Interconnect](#) chapter in volume 3 of the *Cyclone V Device Handbook*.

Figure 6-4. The MPCore Address Map**The SDRAM Region**

The SDRAM region starts at address 0x100000 (1 MB). The top of the region is determined by the L2 cache filter.

The L2 cache contains a filtering mechanism that routes accesses to the SDRAM and L3 interconnect. The filter defines a filter range with start and end addresses. Any access within this filter range is routed to the SDRAM subsystem. Accesses outside of this filter range are routed to the L3 interconnect.

The start and end addresses are specified in the following register fields:

- `reg12_addr_filtering_start.address_filtering_start`
- `reg12_addr_filtering_end.address_filtering_end`

To remap the lower 1MB of SDRAM into the boot region, set the filter start address to 0x0 to ensure accesses between 0x0 and 0xFFFFF are routed to the SDRAM. Independently, you can set the filter end address in 1 MB increments above 0xC0000000 to extend the upper bounds of the SDRAM region. However, you achieve this extended range at the expense of the FPGA peripheral address span. Depending on the address filter settings in the L2 cache, the top of the SDRAM region can range from 0xBFFFFFFF to 0xFBFFFFFF.

For more information about the L2 cache, refer to [“L2 Cache” on page 6-24](#).

The FPGA Slaves Region

The Cortex-A9 MPU subsystem supports the variable-sized FPGA slaves region to communicate with FPGA-based peripherals. This region can start as low as 0xC0000000, depending on the L2 cache filter settings. The top of the FPGA slaves region is located at 0xFBFFFFFF. As a result, the size of the FPGA slaves region can range from 0 to 0x3F000000 bytes.

The HPS Peripherals Region

The HPS peripherals region is the top 64 MB in the address space, starting at 0xFC000000 and extending to 0xFFFFFFFF. The HPS peripherals region is always allocated to the HPS dedicated peripherals for the Altera Cortex-A9 MPU subsystem.

Performance Monitoring Unit

Each Cortex-A9 processor has a Performance Monitoring Unit (PMU). The PMU supports 58 events to gather statistics on the operation of the processor and memory system. Six counters in the PMU accumulate the events in real time. The PMU counters are accessible either from the processor itself, using the Coprocessor 14 (CP14) interface, or from an external debugger. The events are also supplied to the PTM and can be used for trigger or trace.



For more information about the PMU, refer to the *Performance Monitoring Unit* chapter of the *Cortex-A9 Technical Reference Manual*, Revision r3p0, available on the ARM website (infocenter.arm.com).

MPCore Timers

There is one interval timer and one watchdog timer for each processor.

Functional Description

Each timer is private, meaning that only its associated processor can access it. If the watchdog timer is not needed, it can be configured as a second interval timer.

Each private interval and watchdog timer has the following features:

- A 32-bit counter that optionally generates an interrupt when it reaches zero
- Configurable starting values for the counter
- An eight-bit prescaler value to qualify the clock period

Implementation Details

The timers are configurable to either single-shot or auto-reload mode. The timer blocks are clocked by `mpu_periph_clk`, running at $\frac{1}{4}$ the rate of `mpu_clk`.



For more information about private timers, refer to “About the private timer and watchdog blocks” in the *Global timer, Private timers, and Watchdog registers* chapter of the *Cortex-A9 MPCore Technical Reference Manual*, Revision r3p0, available on the ARM website (infocenter.arm.com).

Generic Interrupt Controller

Functional Description

The Generic Interrupt Controller (GIC) supports up to 180 interrupt sources, including dedicated peripherals and IP implemented in the FPGA fabric. In a dual-core system, the GIC is shared by both Cortex-A9 processors. Each processor also has 16 banked software-generated interrupts and 16 banked private peripheral interrupts.

Implementation Details

The configuration and control for the GIC is memory-mapped and accessed through the SCU. The GIC are clocked by mpu_periph_clk, running at $\frac{1}{4}$ the rate of mpu_clk.



For more information about the GIC, refer to the *Interrupt Controller* chapter of the *Cortex-A9 MPCore Technical Reference Manual*, Revision r3p0, available on the ARM website (infocenter.arm.com).

Table 6–3 shows the interrupt map.

Table 6–3. GIC Interrupt Map (Part 1 of 6)

GIC Interrupt Number ⁽¹⁾	Source Block	Interrupt Name	Combined Interrupts	Triggering
32	CortexA9_0	cpu0_parityfail	⁽²⁾	Edge
33	CortexA9_0	cpu0_parityfail_BTAC		Edge
34	CortexA9_0	cpu0_parityfail_GHB		Edge
35	CortexA9_0	cpu0_parityfail_I_Tag		Edge
36	CortexA9_0	cpu0_parityfail_I_Data		Edge
37	CortexA9_0	cpu0_parityfail_TLB		Edge
38	CortexA9_0	cpu0_parityfail_D_Outer		Edge
39	CortexA9_0	cpu0_parityfail_D_Tag		Edge
40	CortexA9_0	cpu0_parityfail_D_Data		Edge
41	CortexA9_0	cpu0_deflags0		Level
42	CortexA9_0	cpu0_deflags1		Level
43	CortexA9_0	cpu0_deflags2		Level
44	CortexA9_0	cpu0_deflags3		Level
45	CortexA9_0	cpu0_deflags4		Level
46	CortexA9_0	cpu0_deflags5		Level
47	CortexA9_0	cpu0_deflags6		Level
48	CortexA9_1	cpu1_parityfail	⁽³⁾	Edge
49	CortexA9_1	cpu1_parityfail_BTAC		Edge
50	CortexA9_1	cpu1_parityfail_GHB		Edge
51	CortexA9_1	cpu1_parityfail_I_Tag		Edge
52	CortexA9_1	cpu1_parityfail_I_Data		Edge
53	CortexA9_1	cpu1_parityfail_TLB		Edge
54	CortexA9_1	cpu1_parityfail_D_Outer		Edge
55	CortexA9_1	cpu1_parityfail_D_Tag		Edge
56	CortexA9_1	cpu1_parityfail_D_Data		Edge
57	CortexA9_1	cpu1_deflags0		Level
58	CortexA9_1	cpu1_deflags1		Level

Table 6-3. GIC Interrupt Map (Part 2 of 6)

GIC Interrupt Number ⁽¹⁾	Source Block	Interrupt Name	Combined Interrupts	Triggering
59	CortexA9_1	cpu1_deflags2		Level
60	CortexA9_1	cpu1_deflags3		Level
61	CortexA9_1	cpu1_deflags4		Level
62	CortexA9_1	cpu1_deflags5		Level
63	CortexA9_1	cpu1_deflags6		Level
64	SCU	scu_parityfail0	—	Edge
65	SCU	scu_parityfail1	—	Edge
66	SCU	scu_ev_abort		Edge
67	L2-Cache	l2_ecc_byte_wr_IRQ	—	Edge
68	L2-Cache	l2_ecc_corrected_IRQ	—	Edge
69	L2-Cache	l2_ecc_uncorrected_IRQ	—	Edge
70	L2-Cache	l2_combined_IRQ	⁽⁴⁾	Level
71	DDR	ddr_ecc_error_IRQ	—	Level
72	FPGA	FPGA_IRQ0	—	Level or Edge
73	FPGA	FPGA_IRQ1	—	Level or Edge
74	FPGA	FPGA_IRQ2	—	Level or Edge
75	FPGA	FPGA_IRQ3	—	Level or Edge
76	FPGA	FPGA_IRQ4	—	Level or Edge
77	FPGA	FPGA_IRQ5	—	Level or Edge
78	FPGA	FPGA_IRQ6	—	Level or Edge
79	FPGA	FPGA_IRQ7	—	Level or Edge
80	FPGA	FPGA_IRQ8	—	Level or Edge
81	FPGA	FPGA_IRQ9	—	Level or Edge
82	FPGA	FPGA_IRQ10	—	Level or Edge
83	FPGA	FPGA_IRQ11	—	Level or Edge
84	FPGA	FPGA_IRQ12	—	Level or Edge
85	FPGA	FPGA_IRQ13	—	Level or Edge
86	FPGA	FPGA_IRQ14	—	Level or Edge
87	FPGA	FPGA_IRQ15	—	Level or Edge
88	FPGA	FPGA_IRQ16	—	Level or Edge
89	FPGA	FPGA_IRQ17	—	Level or Edge
90	FPGA	FPGA_IRQ18	—	Level or Edge
91	FPGA	FPGA_IRQ19	—	Level or Edge
92	FPGA	FPGA_IRQ20	—	Level or Edge
93	FPGA	FPGA_IRQ21	—	Level or Edge
94	FPGA	FPGA_IRQ22	—	Level or Edge
95	FPGA	FPGA_IRQ23	—	Level or Edge
96	FPGA	FPGA_IRQ24	—	Level or Edge
97	FPGA	FPGA_IRQ25	—	Level or Edge

Table 6-3. GIC Interrupt Map (Part 3 of 6)

GIC Interrupt Number ⁽¹⁾	Source Block	Interrupt Name	Combined Interrupts	Triggering
98	FPGA	FPGA_IRQ26	—	Level or Edge
99	FPGA	FPGA_IRQ27	—	Level or Edge
100	FPGA	FPGA_IRQ28	—	Level or Edge
101	FPGA	FPGA_IRQ29	—	Level or Edge
102	FPGA	FPGA_IRQ30	—	Level or Edge
103	FPGA	FPGA_IRQ31	—	Level or Edge
104	FPGA	FPGA_IRQ32	—	Level or Edge
105	FPGA	FPGA_IRQ33	—	Level or Edge
106	FPGA	FPGA_IRQ34	—	Level or Edge
107	FPGA	FPGA_IRQ35	—	Level or Edge
108	FPGA	FPGA_IRQ36	—	Level or Edge
109	FPGA	FPGA_IRQ37	—	Level or Edge
110	FPGA	FPGA_IRQ38	—	Level or Edge
111	FPGA	FPGA_IRQ39	—	Level or Edge
112	FPGA	FPGA_IRQ40	—	Level or Edge
113	FPGA	FPGA_IRQ41	—	Level or Edge
114	FPGA	FPGA_IRQ42	—	Level or Edge
115	FPGA	FPGA_IRQ43	—	Level or Edge
116	FPGA	FPGA_IRQ44	—	Level or Edge
117	FPGA	FPGA_IRQ45	—	Level or Edge
118	FPGA	FPGA_IRQ46	—	Level or Edge
119	FPGA	FPGA_IRQ47	—	Level or Edge
120	FPGA	FPGA_IRQ48	—	Level or Edge
121	FPGA	FPGA_IRQ49	—	Level or Edge
122	FPGA	FPGA_IRQ50	—	Level or Edge
123	FPGA	FPGA_IRQ51	—	Level or Edge
124	FPGA	FPGA_IRQ52	—	Level or Edge
125	FPGA	FPGA_IRQ53	—	Level or Edge
126	FPGA	FPGA_IRQ54	—	Level or Edge
127	FPGA	FPGA_IRQ55	—	Level or Edge
128	FPGA	FPGA_IRQ56	—	Level or Edge
129	FPGA	FPGA_IRQ57	—	Level or Edge
130	FPGA	FPGA_IRQ58	—	Level or Edge
131	FPGA	FPGA_IRQ59	—	Level or Edge
132	FPGA	FPGA_IRQ60	—	Level or Edge
133	FPGA	FPGA_IRQ61	—	Level or Edge
134	FPGA	FPGA_IRQ62	—	Level or Edge
135	FPGA	FPGA_IRQ63	—	Level or Edge

Table 6-3. GIC Interrupt Map (Part 4 of 6)

GIC Interrupt Number ⁽¹⁾	Source Block	Interrupt Name	Combined Interrupts	Triggering
136	DMA	dma_IRQ0	—	Level
137	DMA	dma_IRQ1	—	Level
138	DMA	dma_IRQ2	—	Level
139	DMA	dma_IRQ3	—	Level
140	DMA	dma_IRQ4	—	Level
141	DMA	dma_IRQ5	—	Level
142	DMA	dma_IRQ6	—	Level
143	DMA	dma_IRQ7	—	Level
144	DMA	dma_irq_abort	—	Level
145	DMA	dma_ecc_corrected_IRQ		Level
146	DMA	dma_ecc_uncorrected_IRQ		Level
147	EMAC0	emac0_IRQ	(5)	Level
148	EMAC0	emac0_tx_ecc_corrected_IRQ		Level
149	EMAC0	emac0_tx_ecc_uncorrected_IRQ		Level
150	EMAC0	emac0_rx_ecc_corrected_IRQ		Level
151	EMAC0	emac0_rx_ecc_uncorrected_IRQ		Level
152	EMAC1	emac1_IRQ	(5)	Level
153	EMAC1	emac1_tx_ecc_corrected_IRQ		Level
154	EMAC1	emac1_tx_ecc_uncorrected_IRQ		Level
155	EMAC1	emac1_rx_ecc_corrected_IRQ		Level
156	EMAC1	emac1_rx_ecc_uncorrected_IRQ		Level
157	USB0	usb0_IRQ		Level
158	USB0	usb0_ecc_corrected_IRQ		Level
159	USB0	usb0_ecc_uncorrected_IRQ		Level
160	USB1	usb1_IRQ		Level
161	USB1	usb1_ecc_corrected_IRQ		Level
162	USB1	usb1_ecc_uncorrected_IRQ		Level
163	CAN0	can0_sts_IRQ		Level
164	CAN0	can0_mo_IRQ		Level
165	CAN0	can0_ecc_corrected_IRQ		Level
166	CAN0	can0_ecc_uncorrected_IRQ		Level
167	CAN1	can1_sts_IRQ		Level
168	CAN1	can1_mo_IRQ		Level
169	CAN1	can1_ecc_corrected_IRQ		Level
170	CAN1	can1_ecc_uncorrected_IRQ		Level
171	SDMMC	sdmmc_IRQ		Level
172	SDMMC	sdmmc_porta_ecc_corrected_IRQ		Level
173	SDMMC	sdmmc_porta_ecc_uncorrected_IRQ		Level

Table 6-3. GIC Interrupt Map (Part 5 of 6)

GIC Interrupt Number ⁽¹⁾	Source Block	Interrupt Name	Combined Interrupts	Triggering
174	SDMMC	sdmmc_portb_ecc_corrected_IRQ		Level
175	SDMMC	sdmmc_portb_ecc_uncorrected_IRQ		Level
176	NAND	nand_IRQ		Level
177	NAND	nandr_ecc_corrected_IRQ		Level
178	NAND	nandr_ecc_uncorrected_IRQ		Level
179	NAND	nandw_ecc_corrected_IRQ		Level
180	NAND	nandw_ecc_uncorrected_IRQ		Level
181	NAND	nande_ecc_corrected_IRQ		Level
182	NAND	nande_ecc_uncorrected_IRQ		Level
183	QSPI	qspi_IRQ		Level
184	QSPI	qspi_ecc_corrected_IRQ		Level
185	QSPI	qspi_ecc_uncorrected_IRQ		Level
186	SPI0	spi0_IRQ	(6)	Level
187	SPI1	spi1_IRQ	(6)	Level
188	SPI2	spi2_IRQ	(6)	Level
189	SPI3	spi3_IRQ	(6)	Level
190	I2C0	i2c0_IRQ	(7)	Level
191	I2C1	i2c1_IRQ	(7)	Level
192	I2C2	i2c2_IRQ	(7)	Level
193	I2C3	i2c3_IRQ	(7)	Level
194	UART0	uart0_IRQ		Level
195	UART1	uart1_IRQ		Level
196	GPIO0	gpio0_IRQ	—	Level
197	GPIO1	gpio1_IRQ	—	Level
198	GPIO2	gpio2_IRQ	—	Level
199	Timer0	timer_l4sp_0_IRQ	(8)	Level
200	Timer1	timer_l4sp_1_IRQ	(8)	Level
201	Timer2	timer_oscl_0_IRQ	(8)	Level
202	Timer3	timer_oscl_1_IRQ	(8)	Level
203	Watchdog0	wdog0_IRQ	—	Level
204	Watchdog1	wdog1_IRQ	—	Level
205	Clock manager	clkmgr_IRQ		Level
206	Clock manager	mpuawakeup_IRQ		Level
207	FPGA manager	fpga_man_IRQ	(9)	Level
208	CoreSight	nCTIIRQ[0]		Level
209	CoreSight	nCTIIRQ[1]		Level

Table 6-3. GIC Interrupt Map (Part 6 of 6)

GIC Interrupt Number ⁽¹⁾	Source Block	Interrupt Name	Combined Interrupts	Triggering
210	On-chip RAM	ram_ecc_corrected_IRQ		Level
211	On-chip RAM	ram_ecc_uncorrected_IRQ		Level
Notes to Table 6-3: (1) To ensure that you are using the correct GIC interrupt number, your code should refer to the symbolic interrupt name, as shown in the Interrupt Name column. Symbolic interrupt names are defined in a header file distributed with the source installation for your operating system. (2) This interrupt combines the interrupts named cpu0_parityfail_*. (3) This interrupt combines the interrupts named cpu1_parityfail_*. (4) This interrupt combines the following interrupts: DECERRINTR, ECNTRINTR, ERRRDINTR, ERRRTINTR, ERRWDINTR, ERRWTINTR, PARRDINTR, PARRTINTR, and SLVERRINTR. (5) This interrupt combines sbd_intr_o, lpi_intr_o, and pmt_intr_o. (6) This interrupt combines the following interrupts: ssi_txe_intr, ssi_txo_intr, ssi_rxf_intr, ssi_rxo_intr, ssi_rxu_intr, and ssi_mst_intr. (7) This interrupt combines the following interrupts: ic_rx_under_intr, ic_rx_full_intr, ic_tx_over_intr, ic_tx_empty_intr, ic_rd_req_intr, ic_tx_abrt_intr, ic_rx_done_intr, ic_activity_intr, ic_stop_det_intr, ic_start_det_intr, and ic_gen_call_intr. (8) This interrupt combines TIMINT1 and TIMINT2. (9) This interrupt combines the following interrupts: fpga_man_irq[7..0].				

Global Timer

The MPU features a global 64-bit, auto-incrementing timer, which is primarily used by the operating system.

Functional Description

The global timer is accessible by the processors using memory-mapped access through the SCU. The global timer has the following features:

- 64-bit incrementing counter with an auto-incrementing feature. It continues incrementing after sending interrupts.
- Memory-mapped in the private memory region.
- Accessed at reset in Secure State only. It can only be set once, but secure code can read it at any time.
- Accessible to both Cortex-A9 processors in the MPCore.

Implementation Details

Each Cortex-A9 processor has a private 64-bit comparator that generates a private interrupt when the counter reaches the specified value. Each Cortex-A9 processor uses the banked ID, ID27, for this interrupt. ID27 is sent to the GIC as a Private Peripheral Interrupt (PPI).

The global timer are clocked by mpu_periph_clk, running at ¼ the rate of mpu_clk.



For more information about the global timer, refer to “About the Global Timer” in the *Global timer, Private timers, and Watchdog registers* chapter of the *Cortex-A9 MPCore Technical Reference Manual*, Revision r3p0, available on the ARM website (infocenter.arm.com).

Snoop Control Unit

The SCU manages data traffic for the Cortex-A9 processors and the memory system, including the L2 cache. In a multi-master system, the processors and other masters can operate on shared data. The SCU ensures that each processor operates on the most up-to-date copy of data, maintaining cache coherency.

Functional Description

The SCU is used to connect the Cortex-A9 processors and the ACP to the L2 cache controller. The SCU performs the following functions:

- When the processors are set to SMP mode, the SCU maintains data cache coherency between the processors.

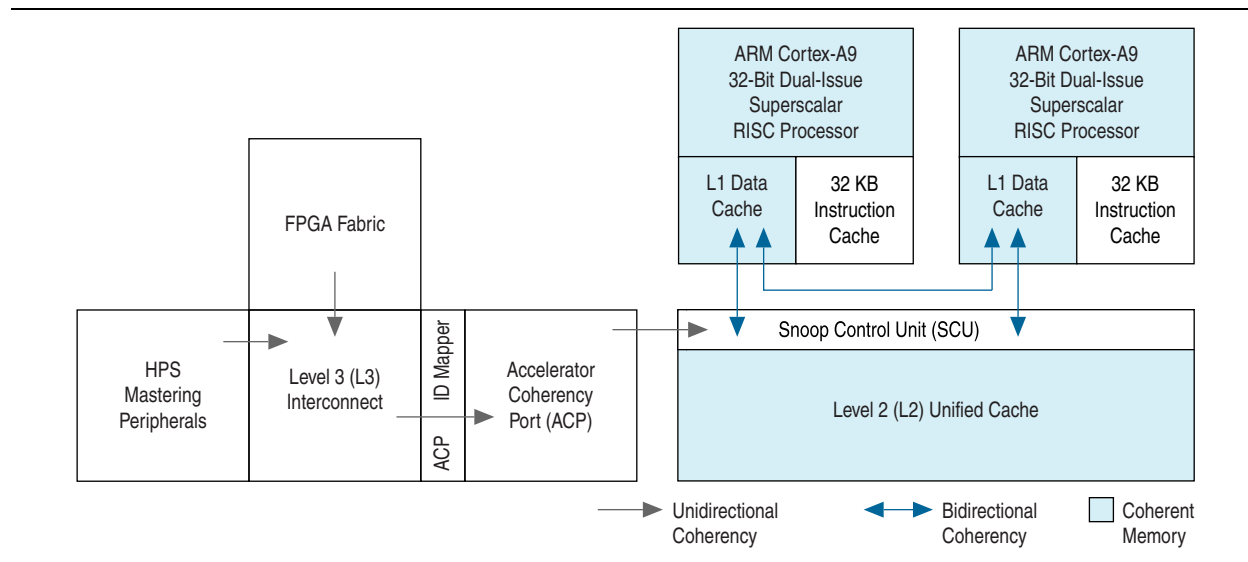


The SCU does not maintain coherency of the instruction caches.

- Initiates L2 cache memory accesses
- Arbitrates between processors requesting L2 access
- Manages ACP access with cache coherency capabilities.

Figure 6–5 shows the SCU in a dual-processor system, illustrating the flow of data among the L1 data caches and the SCU.

Figure 6–5. Coherent Memory, Snoop Control Unit, and Accelerator Coherency Port



For more information about the SCU, refer to the *Snoop Control Unit* chapter of the *Cortex-A9 MPCore Technical Reference Manual*, Revision r3p0, available on the ARM website (infocenter.arm.com).

Implementation Details

When the processor writes to any coherent memory location, the SCU ensures that the relevant data is coherent (updated, tagged, or invalidated). Similarly, the SCU monitors read operations from a coherent memory location. If the required data is already stored within the other processor's L1 cache, the data is returned directly to the requesting processor. If the data is not in L1 cache, the SCU issues a read to the L2 cache. If the data is not in the L2 cache memory, the read is finally forwarded to main memory. The primary goal is to minimize power consumption and maximize overall memory performance.

The SCU maintains bidirectional coherency between the L1 data caches belonging to the processors. When one processor writes to a location in its L1 cache, if the same location is cached in the other L1 cache, the SCU updates it.

Non-coherent data passes through as a standard read or write operation.

The SCU also arbitrates between the Cortex-A9 processors if both attempt simultaneous access to the L2 cache, and manages accesses from the ACP.

Accelerator Coherency Port

The ACP allows peripherals—including FPGA-based peripherals—to maintain data coherency with the Cortex-A9 MPCore processors and the SCU. As shown in [Figure 6-5 on page 6-18](#), dedicated peripherals in the HPS, and those built in FPGA logic, access the coherent memory through the ACP ID mapper and the ACP. For information about the ACP ID mapper, refer to [“ACP ID Mapper” on page 6-20](#).

The high-bandwidth peripherals, including the FPGA data ports, connect to the L3 interconnect.

Burst Sizes and Byte Strokes

The ACP improves system performance for hardware accelerators in the FPGA fabric. However, in order to achieve high levels of performance, you must use the burst types listed in [Table 6-4](#). The other burst types have significantly lower performance.

Table 6-4. Recommended Burst Types

Burst Type	Beats	Width (Bits)	Address Type	Byte Strokes
Wrapping	4	64	64-bit aligned	Asserted
Incrementing	4	64	32-bit aligned	Asserted



If the slave port of the FPGA-to-HPS bridge is not 64 bits wide, you must supply bursts to the FPGA-to-HPS bridge that are upsized or downsized to the burst types above. For example, if the slave data width of the FPGA-to-HPS bridge is 32 bits, then bursts of eight beats by 32 bits are required to access the ACP efficiently.



If the address and burst size of the transaction to the ACP matches either of the conditions above, the logic in the MPU assumes the transaction has all its byte strokes set. If the byte strokes are not all set, then the write does not actually overwrite all the bytes in the word. Instead, the cache assumes the whole cache line is valid. If this line is dirty (and therefore gets written out to SDRAM), data corruption might occur.

Exclusive and Locked Accesses

The ACP does not support exclusive accesses to coherent memory. The ACP supports exclusive accesses to non-coherent memory; however, it is important that the exclusive access transaction is not affected by the upsizing and downsizing logic of the FPGA-to-HPS bridge or the L3 interconnect. If the exclusive access is broken into multiple transactions due to the sizing logic, the exclusive access bit is cleared by the bridge or interconnect and the exclusive access fails.



Altera recommends that exclusive accesses bypass the ACP altogether, either through the 32-bit slave port of the SDRAM controller connected directly to the L3 interconnect or through the FPGA-to-SDRAM interface.



For more information about the exclusive access support of the SDRAM controller subsystem, refer to the *SDRAM Controller Subsystem* chapter in volume 3 of the *Cyclone® V Device Handbook*.

The ACP ID mapper does not support locked accesses. To ensure mutually exclusive access to shared data, use the exclusive access support built into the SDRAM controller.

ACP ID Mapper

The ACP ID mapper is situated between the level 3 (L3) interconnect and the MPU subsystem ACP slave. It is responsible for mapping 12-bit Advanced Microcontroller Bus Architecture (AMBA®) Advanced eXtensible Interface (AXI™) IDs (input IDs) from the L3 interconnect to 3-bit AXI IDs (output IDs) supported by the ACP slave port.

The ACP ID mapper also implements a 1 GB coherent window into 4 GB address space.

Functional Description

The ACP slave supports up to six masters. However, custom peripherals implemented in the FPGA fabric can have a larger number of masters that need to access the ACP slave. The ACP ID mapper allows these masters to access the ACP.

The ACP ID mapper resides between the interconnect and the ACP slave of the MPU subsystem. It has the following characteristics:

- Support for up to six concurrent ID mappings
- 1 GB coherent window into 4 GB MPCore address space
- Remaps the 5-bit user sideband signals used by the Snoop Control Unit (SCU) and L2 cache.



For more information about AXI user sideband signals, refer to the *CoreLink Level 2 Cache Controller L2C-310 Technical Reference Manual*, which you can download from the ARM website (infocenter.arm.com).

Implementation Details

The ACP is accessed by masters that require access to coherent memory. The ACP slave port can be accessed by the master peripherals of the L3 interconnect, as well as by masters implemented in the FPGA fabric (via the FPGA-to-HPS bridge). [Figure 6-1 on page 6-2](#) shows the ACP ID mapper.

The ACP ID mapper supports the following ID mapping modes:

- Dynamic mapping
- Fixed mapping

Software can select the ID mapping on a per-ID basis. For input IDs that are configured for fixed mapping, there is a one-to-one mapping from input IDs to output IDs. When an input ID is configured for dynamic mapping, it is automatically mapped to an available output ID. The dynamic mode is more flexible because the hardware handles the mapping. The hardware mapping allows you to use one output ID for more than one input ID. Output IDs are assigned to input IDs on a first-come, first-served basis.

Out of the total of eight output IDs, only six are available to masters of the L3 interconnect. The first two output IDs (0 and 1) are dedicated to the Cortex-A9 processor cores in the MPU subsystem, leaving the last six output IDs (2-7) available to the ACP ID mapper. Output IDs 2-6 support fixed and dynamic modes of operation while output ID 7 supports dynamic only.

The operating modes are programmable through accesses to the control and status registers in the ACP ID mapper, available via the level 4 peripheral bus connection. At reset time, the ACP ID mapper defaults to dynamic ID mapping for all output IDs except ID 2, which resets to a fixed mapping for the Debug Access Port (DAP) input ID.

[Table 6-1](#) summarizes the expected usage of the 3-bit output IDs, and their settings at reset.

Table 6-5. ID Intended Usage

Output ID	Reset State	Intended Use
7	Dynamic	Dynamic mapping only
6	Dynamic	Fixed or dynamic, programmed by software.
5		
4		
3		
2	Fixed at 0x001 (DAP)	Assigned to the input ID of the DAP at reset. After reset, can be either fixed or dynamic, programmed by software.
1	—	Not used by the ACP ID Mapper
0		

For masters that cannot drive the AXI user sideband signal of incoming transactions, the ACP ID mapper can control overriding this signal. The ACP ID mapper can also control which 1 GB coherent window into memory is accessed by masters of the L3 interconnect. Each fixed mapping can be assigned a different user sideband signal and memory window to allow specific settings for different masters. All dynamic mappings share a common user sideband signal and memory window setting.

Transaction Capabilities

At any one time, the ACP ID mapper can accept and issue up to 15 transactions per ID mapping. Read and write ID mappings are managed in separate lists, allowing more unique input IDs to be remapped at any given time. If a master issues a series of reads and writes with the same input ID, there are no ordering restrictions.

Because there are only six output IDs available, there can be no more than six read and six write transactions with unique IDs in progress at any one time. The write acceptance of the ACP slave is five transactions, and the read acceptance is 13 transactions. Only four coherent read transactions per ID mapping can be outstanding at one time.

Dynamic Mapping Mode

In dynamic mode, every unique input ID that is received from the L3 master port is assigned to an unused output ID. The new output ID is applied to the transaction as it is issued to the ACP slave of the SCU. Any transaction that arrives to the ACP ID mapper with an input ID that matches an already-in-progress transaction is mapped to the same output ID. Once all transactions on an ID mapping have completed, that output ID is released and can be used again for other input IDs.

Fixed Mapping Mode

In fixed mode, output IDs 2 through 6 can be assigned by software to a specific 12-bit input ID. This ability makes it possible to use the lock-by-master feature of the L2 cache controller, because the input transaction ID from the master is always assigned to a specific output ID. Unlike dynamic mode, ID 7 is not available for fixed mapping because it is reserved for dynamic mode only to avoid system deadlocks.

The ACP ID mapper has two banks of registers to control the behavior of the mappings, namely, a request bank and a read-only status bank. Both banks contain the same number of registers. To change the settings for a particular mapping (either a specific fixed ID, or all dynamic mappings), software should write to the appropriate register in the request bank. The hardware examines the request, and only applies the change when safe to do so, which is when there are no outstanding transactions with the output ID. When the change is applied, the status register is updated. Software should check that the change has actually taken place by polling the corresponding status register.

Table 6–6 shows the input IDs issued from the interconnect for each HPS peripheral master that can access the ACP ID mapper.

Table 6–6. HPS Peripheral Master Input IDs

Interconnect Master	ID ⁽¹⁾
DMA	00000xxxx011
EMAC0	10000xxxx001
EMAC1	10000xxxx010
USB0	100000000011
USB1	100000000110
NAND	1xxxxxxxx100
ETR	100000000000
DAP	000000000001
SD/MMC	100000000101
FPGA-to-HPS bridge	0xxxxxxxx100
Notes to Table 6–6:	
(1) Values are in binary. The letter x denotes variable ID bits each master passes with each transaction.	

Control of the AXI User Sideband Signals

The ACP ID mapper module allows control of the AXI user sideband signal values. Not all masters drive these signals, so the ACP ID mapper makes it possible to drive the 5-bit user sideband signal with either a default value (in dynamic mode) or specific values (in fixed mode).

There are registers available to configure the default values of the user sideband signals for all transactions, and fixed values of these signals for particular transactions in fixed mapping mode. In dynamic mode, the user sideband signals of incoming transactions are mapped with the default values stored in the register. In fixed mapping mode, the input ID of the transaction is mapped to the 3-bit output ID and the user sideband signals of the transaction are mapped with the values stored in the register that corresponds to the output ID. One important exception, however, is that the ACP ID mapper always allows user sideband signals from the FPGA-to-HPS bridge to pass through to the ACP regardless of the user sideband value associated with the ID.

Memory Region Remap

The ACP ID mapper has 1 GB of address space, which is by default a view into the bottom 1 GB of SDRAM. The mapper also allows transactions to be routed to different 1 GB-sized memory regions, called pages, in both dynamic and fixed modes. The two most significant bits of incoming 32-bit AXI address signals are replaced with the 2-bit user-configured address page decode information. The page decoder uses the values shown in Table 6-7.

Table 6-7. Page Decoder Values

Page	Address Range
0	0x00000000–0x3FFFFFFF
1	0x40000000–0x7FFFFFFF
2	0x80000000–0xBFFFFFFF
3	0xC0000000–0xFFFFFFFF

With this page decode information, a master can read or write to any 1 GB region of the 4 GB memory space while maintaining cache coherency with the MPU subsystem.

Using this feature, a debugger can have a coherent view into main memory, without having to stop the processor. For example, at reset the DAP input ID (0x001) is mapped to output ID 2, so the debugger can vary the 1 GB window that the DAP accesses without affecting any other traffic flow to the ACP.

L2 Cache

The MPU subsystem includes a secondary 512 KB L2 shared, unified cache memory.

Functional Description

The L2 cache is much larger than the L1 cache. The L2 cache has significantly lower latency than external memory. The L2 cache is up to eight-way associative, configurable down to one-way (direct mapped). Like the L1 cache, the L2 cache can be locked by cache line, locked by way, or locked by bus master.

The L2 cache implements error correction codes (ECCs) and ECC error reporting. The cache can report a number of events to the processor and operating system.


The L2 cache consists of the ARM L2C-310 L2 cache controller configured as follows:

- 512 KB total memory
- Eight-way associativity
- Physically addressed, physically tagged
- Line length of 32 bytes

- Critical first word linefills
- Support for all AXI cache modes, as shown in [Table 6-8](#).

Table 6-8. AXI Cache Mode Support

Cache Mode
Write-through ⁽¹⁾
Write-back ⁽¹⁾
Read allocate
Write allocate
Read and write allocate
Note to Table 6-8: (1) Restrictions exist when using ECCs. For more information about SEU protection, refer to the System Manager chapter in volume 3 of the <i>Cyclone V Device Handbook</i> .

- Single event upset (SEU) protection
 - Parity on Tag RAM
 - ECC on L2 Data RAM
-  For more information about SEU protection, refer to the [System Manager](#) chapter in volume 3 of the *Cyclone V Device Handbook*.
- Two slave ports mastered by the SCU
- Two master ports connected to the following slave ports:
 - SDRAM controller, 64 bit slave port width
 - L3 interconnect, 64 bit slave port width
- Cache lockdown capabilities as follows:
 - Line lockdown
 - Lockdown by way
 - Lockdown by master (both processors and ACP masters)
- TrustZone support
- Cache event monitoring. For more information, refer to “[L2 Cache Event Monitoring](#)” on page 6-27.

[Figure 6-1 on page 6-2](#) shows the L2 cache. The L2 cache can access either the L3 interconnect fabric or the SDRAM. The L2 cache address filtering determines how much address space is allocated to the HPS-to-FPGA bridge and how much is allocated to SDRAM, as described in “[Memory Management Unit](#)” on page 6-9.

ECC Support

The L2 cache has the option of using ECCs to protect against SEU errors in the cache RAM.

Enabling ECCs does not affect the performance of the L2 cache. The ECC bits are calculated only for writes to the data RAM that are 64 bits wide (8 bytes, or one-quarter of the cache line length). The ECC logic does not perform a read-modify-write when calculating the ECC bits. The ECC protection bits are not valid in the following cases:

- Data is written that is not 64-bit aligned in memory
- Data is written that is less than 64 bits in width

In these cases the Byte Write Error interrupt is asserted. Cache data is still written when such an error occurs. However, the ECC error detection and correction continues to function. Therefore, the cache data is likely to be incorrect on subsequent reads.

To use ECCs, the software and system must meet the following requirements:

- L1 and L2 cache must be configured as write-back allocate for any cacheable memory region
- FPGA soft IP using the ACP must only perform the following types of data writes:
 - 64-bit aligned in memory
 - 64 bit wide accesses



For more information about SEU errors, refer to the *System Manager* chapter in volume 3 of the *Cyclone V Device Handbook*.

Implementation Details

Table 6–9 shows the parameter settings for the cache controller.

Table 6–9. Cache Controller Configuration

Feature	Meaning
Cache way size	64 KB
Number of cache ways	8 ways
RAM latencies	2 cycles of latency
Parity logic	Parity logic enabled
Lockdown by master	Lockdown by master enabled
Lockdown by line	Lockdown by line enabled
AXI ID width on slave ports	6 AXI ID bits on slave ports
Address filtering	Address filtering logic enabled
Speculative read	Logic for supporting speculative read enabled
Presence of ARUSERMx and AWUSERMx sideband signals	Sideband signals enabled



For further information about cache controller configurable options, refer to the *CoreLink Level 2 Cache Controller L2C-310 Technical Reference Manual*, Revision r3p2, available on the ARM website (infocenter.arm.com).

L2 Cache Lockdown Capabilities

The L2 cache has three methods to lock data in the cache RAMs:

- Lockdown by line—Used to lock lines in the cache. This is commonly used for loading critical sections of software into the cache temporarily.
- Lockdown by way—Allows any or all of the eight cache ways to be locked. This is commonly used for loading critical data or code into the cache.
- Lockdown by master—Allows cache ways to be dedicated to a single master port. This allows a large cache to look like smaller caches to multiple master ports. The L2 cache can be mastered by CPU0, CPU1, or the six ACP masters, for a total of eight possible master ports.



For more information about L2 cache lockdown capabilities, refer to “Cache operation” in the *Functional Overview* chapter of the *CoreLink Level 2 Cache Controller L2C-310 Technical Reference Manual*, Revision r3p2, available on the ARM website (infocenter.arm.com).

L2 Cache Event Monitoring

The L2 cache supports the built-in cache event monitoring signals shown in [Table 6-10](#). The L2 cache can count two of the events at any one time.

Table 6-10. L2 Cache Events

Event	Description
CO	Eviction (cast out) of a line from the L2 cache.
DRHIT	Data read hit in the L2 cache.
DRREQ	Data read lookup to the L2 cache. Subsequently results in a hit or miss.
DWHIT	Data write hit in the L2 cache.
DWREQ	Data write lookup to the L2 cache. Subsequently results in a hit or miss.
DWTREQ	Data write lookup to the L2 cache with write-through attribute. Subsequently results in a hit or miss.
EPFALLOC	Prefetch hint allocated into the L2 cache.
EPFHIT	Prefetch hint hits in the L2 cache.
EPFRCVDS0	Prefetch hint received by slave port S0.
EPFRCVDS1	Prefetch hint received by slave port S1.
IPFALLOC	Allocation of a prefetch generated by L2 cache controller into the L2 cache.
IRHIT	Instruction read hit in the L2 cache.
IRREQ	Instruction read lookup to the L2 cache. Subsequently results in a hit or miss.
SPNIDEN	Secure privileged non-invasive debug enable.
SRCONFS0	Speculative read confirmed in slave port S0.
SRCONFS1	Speculative read confirmed in slave port S1.
SRRCVDS0	Speculative read received by slave port S0.
SRRCVDS1	Speculative read received by slave port S1.
WA	Allocation into the L2 cache caused by a write, with write-allocate attribute, miss.

- For more information about the built-in L2 event monitoring capability, refer to “Implementation details” in the *Functional Overview* chapter of the *CoreLink Level 2 Cache Controller L2C-310 Technical Reference Manual*, Revision r3p2, available on the ARM website (infocenter.arm.com).

In addition, the L2 cache events can be captured and timestamped using dedicated debugging circuitry.

- For more information about L2 event capture, refer to the *Debug* chapter of the *Cortex-A9 MPCore Technical Reference Manual*, Revision r3p0, available on the ARM website (infocenter.arm.com).

Debugging Modules

The MPU subsystem includes debugging resources through ARM CoreSight on-chip debugging and trace. The following functionality is included:

- Individual program trace for each processor
- Event trace for the Cortex-A9 MPCore
- Cross triggering between processors and other HPS debugging features

Program Trace

Each processor has an independent PTM that provides real-time instruction flow trace. The PTM is compatible with a number of third-party debugging tools.

The PTM provides trace data in a highly compressed format. The trace data includes tags for specific points in the program execution flow, called waypoints. Waypoints are specific events or changes in the program flow.

The PTM recognizes and tags the waypoints listed in [Table 6–11](#).

Table 6–11. Waypoints Supported by the PTM


Type	Additional Waypoint Information
Indirect branches	Target address and condition code
Direct branches	Condition code
Instruction barrier instructions	—
Exceptions	Location where the exception occurred
Changes in processor instruction set state	—
Changes in processor security state	—
Context ID changes	—
Entry to and return from debug state when Halting debug mode is enabled	—

The PTM optionally provides additional information for waypoints, including the following.

- Processor cycle count between waypoints
- Global timestamp values

 For information about global timestamps, refer to the *CoreSight Debug and Trace* chapter in volume 3 of the *Cyclone V Device Handbook*.


- Target addresses for direct branches

 For more information about the PTM, refer to the *CoreSight PTM-A9 Technical Reference Manual*, Revision r1p0, available on the ARM website (infocenter.arm.com).

Event Trace


Events from each processor can be used as inputs to the PTM. The PTM can use these events as trace and trigger conditions.


For more information about the event trace, refer to “*Performance Monitoring Unit*” on page 6–11.

 For more information about the trigger and trace capabilities, refer to the *CoreSight PTM-A9 Technical Reference Manual*, Revision r1p0, available on the ARM website (infocenter.arm.com).

Cross-Triggering

The PTM can export trigger events and perform actions on trigger inputs. The cross-trigger signals interface with other HPS debugging components including the FPGA fabric. Also, a breakpoint in one processor can trigger a break in the other.


 For detailed information about cross-triggering, refer to the *CoreSight Debug and Trace* chapter in volume 3 of the *Cyclone V Device Handbook*.

 For more information about debugging hardware in the MPU, refer to the *CoreSight Debug and Trace* chapter in volume 3 of the *Cyclone V Device Handbook*.

Cortex-A9 MPU Subsystem Register Implementation

The following configurations are available through registers in the Cortex-A9 subsystem:

- All processor-related controls, including the MMU and L1 caches, are controlled using the Coprocessor 15 (CP15) registers of each individual processor.
- All SCU registers, including control for the timers and GIC, are memory map accessible
- All L2 cache registers are memory-mapped.

 For an address map of peripheral slave ports, including the SCU and L2 cache, refer to the *Introduction to the Hard Processor System* chapter in volume 3 of the *Cyclone V Device Handbook*. For detailed definitions of the registers for the Altera Cortex-A9 MPU subsystem, refer to the *Cortex-A9 MPCore Technical Reference Manual*, Revision r3p0, and the *CoreLink Level 2 Cache Controller L2C-310 Technical Reference Manual*, Revision r3p2, available on the ARM website (infocenter.arm.com).

Document Revision History

Table 6–12 shows the revision history for this document.

Table 6–12. Document Revision History

Date	Version	Changes
November 2012	1.2	Minor updates.
May 2012	1.1	<ul style="list-style-type: none"> ■ Add description of the ACP ID mapper ■ Consolidate redundant information
January 2012	1.0	Initial release.

This section includes the following chapters:

- Chapter 7, CoreSight Debug and Trace



For information about the revision history for chapters in this section, refer to “Document Revision History” in each individual chapter.

The hard processor system (HPS) debug infrastructure provides visibility and control of the HPS modules, the ARM® Cortex™-A9 microprocessor unit (MPU) subsystem, and user logic implemented in the FPGA fabric. The debug system design incorporates ARM® CoreSight™ components.

The HPS contains the following ARM CoreSight debug components:

- “Debug Access Port (DAP)” on page 7–4
- “System Trace Macrocell (STM)” on page 7–4
- “Trace Funnel” on page 7–5
- “Embedded Trace FIFO (ETF)” on page 7–5
- “AMBA Trace Bus Replicator (Replicator)” on page 7–5
- “Embedded Trace Router (ETR)” on page 7–5
- “Trace Port Interface Unit (TPIU)” on page 7–6
- “Embedded Cross Trigger (ECT) System” on page 7–6
- “Program Trace Macrocell (PTM)” on page 7–10

Features of CoreSight Debug and Trace

The CoreSight debug and trace system offers the following features:

- Real-time program flow instruction trace through a separate PTM for each processor
- Host debugger JTAG interface
- Connections for cross-trigger and STM-to-FPGA interfaces, which enable soft IP generation of triggers and system trace messages
- Instruction trace interface through TPIU for trace analysis tools
- Custom message injection through STM into trace stream for delivery to host debugger
- STM and PTM trace sources multiplexed into a single stream through the Trace Funnel

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- Capability to route trace data to any slave accessible to the ETR AXI master connected to the level 3 (L3) interconnect
- Capability for the following SoC modules to trigger each other through the embedded cross-trigger system:
 - FPGA fabric
 - A9-0 processor
 - A9-1 processor
 - PTM-0
 - PTM-1
 - STM
 - ETF
 - ETR
 - TPIU
 - csCTI
 - CTI-0
 - CTI-1
 - FPGA-CTI
 - csCTM
 - CTM

ARM CoreSight Documentation

The following ARM CoreSight specifications and documentation provide a more thorough description of the ARM CoreSight components in the HPS debug system:

- *CoreSight Technology, System Design Guide, ARM DGI 0012D*
- *CoreSight Architecture Specification, ARM IHI 0029B*
- *ARM Debug Interface v5, Architecture Specification, ARM IHI 0031A*
- *Embedded Cross Trigger Technical Reference Manual, ARM DDI 0291A*
- *CoreSight Components Technical Reference Manual, ARM DDI 0314H*
- *CoreSight Program Flow Trace, Architecture Specification, ARM IHI 0035A*
- *CoreSight PTM-A9 Technical Reference Manual, ARM DDI 0401B*
- *CoreSight System Trace Macrocell Technical Reference Manual, ARM DDI 0444A*
- *System Trace Macrocell, Programmers' Model Architecture Specification, ARM IHI 0054*
- *CoreSight Trace Memory Controller Technical Reference Manual, ARM DDI 0461B*

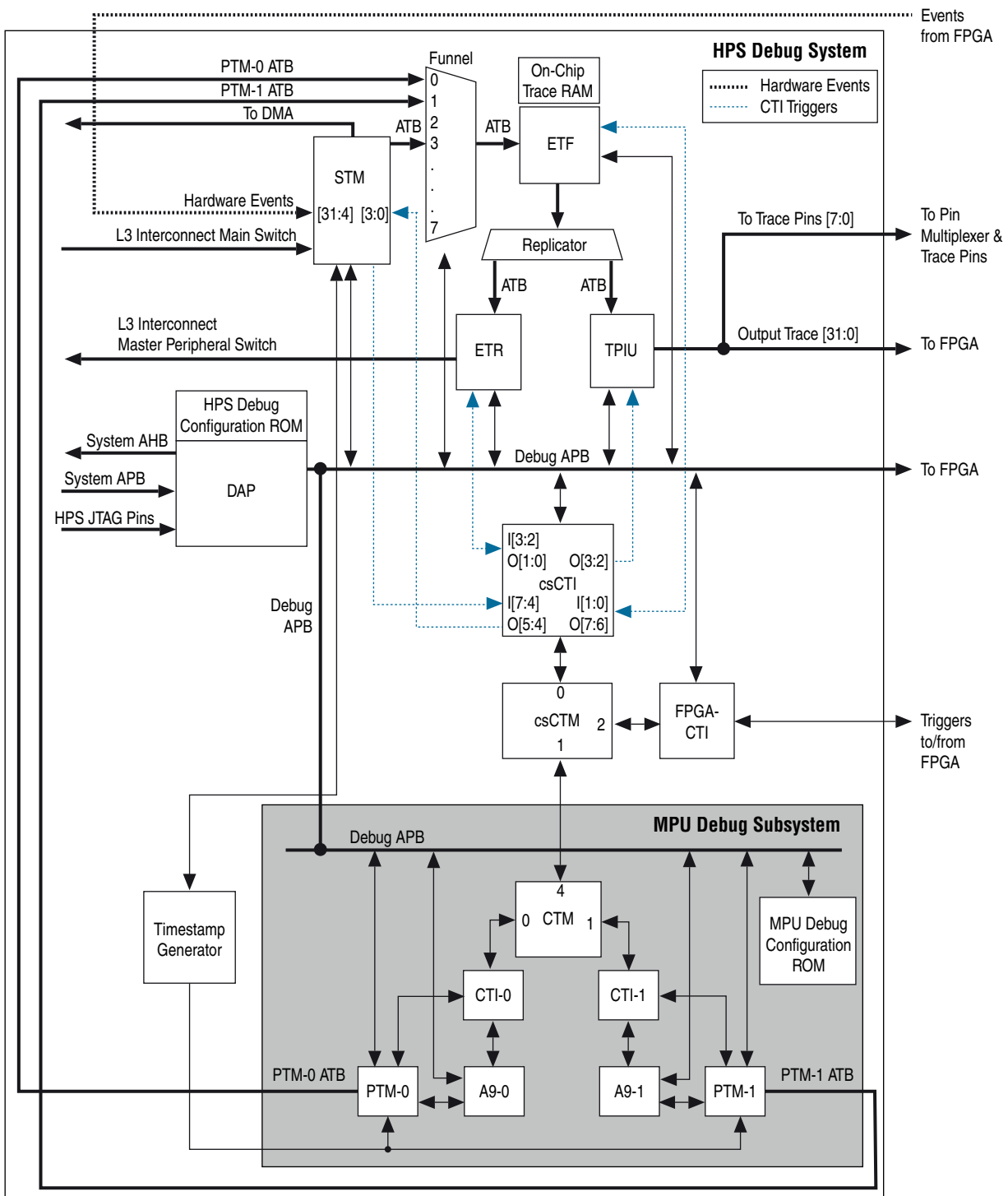


You can download the documents from the ARM website (infocenter.arm.com).

CoreSight Debug and Trace Block Diagram and System Integration

Figure 7-1 shows an overview block diagram of the HPS CoreSight debug and trace system.

Figure 7-1. Debug System Block Diagram



Functional Description of CoreSight Debug and Trace

CoreSight systems provide all the infrastructure you require to debug, monitor, and optimize the performance of a complete HPS design. CoreSight technology addresses the requirement for a multicore debug and trace solution with high bandwidth for whole systems beyond the processor core.

CoreSight technology provides the following features:

- Cross-trigger support between SoC subsystems
- High data compression
- Multisource trace in a single stream
- Standard programming models for standard tool support



For more information about the CoreSight technology, refer to the *CoreSight Components Technical Reference Manual* and the *CoreSight Technology System Design Guide*, which you can download from the ARM website (infocenter.arm.com).

The following sections provide brief descriptions of ARM CoreSight components provided in the HPS debug system.

Debug Access Port (DAP)

The DAP provides the necessary ports for a host debugger to connect to and communicate with the HPS through a JTAG interface connected to dedicated HPS pins that is independent of the JTAG for the FPGA. The JTAG interface provided with the DAP allows a host debugger to access various modules inside the HPS. Additionally, a debug monitor executing on either processor can access different HPS components by interfacing with the system Advanced Microcontroller Bus Architecture (AMBA®) Advanced Peripheral Bus (APB™) slave port of the DAP. The system APB slave port occupies 2 MB of address space in the HPS. Both the JTAG port and system APB port have access to the debug APB master port of the DAP. As shown in [Figure 7-1](#), all CoreSight components are connected to the debug APB.

A host debugger can access any HPS memory-mapped resource in the system via the DAP system master port. Requests made over the DAP system master port are impacted by reads and writes to peripheral registers.



For more information, refer to the *CoreSight Components Technical Reference Manual*, which you can download from the ARM website (infocenter.arm.com).

System Trace Macrocell (STM)

The STM allows messages to be injected into the trace stream for delivery to the host debugger receiving the trace data. These messages can be sent via stimulus ports or the hardware event interface. The STM allows the messages to be time stamped.

The STM provides an AMBA Advanced eXtensible Interface (AXI™) slave interface used to create trace events. The interface can be accessed by the MPU subsystem, direct memory access (DMA) controller, and masters implemented as soft logic in the FPGA fabric via the FPGA-to-HPS bridge. The AXI slave interface supports three address segments, where each address segment is 16 MB and each segment supports up to 65536 channels. Each channel occupies 256 bytes of address space.

The STM also provides 32 hardware event pins. The higher-order 28 pins (31:4) are connected to the FPGA fabric, allowing logic inside FPGA to insert messages into the trace stream. When the STM detects a rising edge on an event pin, a message identifying the event is inserted into the stream. The lower four event pins (3:0) are connected to csCTI.



For more information, refer to the *CoreSight System Trace Macrocell Technical Reference Manual*, which you can download from the ARM website (infocenter.arm.com).

Trace Funnel

The Trace Funnel multiplexes three trace sources into a single trace stream. Port 0 of the Trace Funnel is connected to the PTM for CPU 0. Port 1 of the Trace Funnel is connected to the PTM for CPU 1. Port 3 of the Trace Funnel is connected to the STM. Port 2 and Port 4 through Port 7 are not used.



For more information, refer to the *CoreSight Components Technical Reference Manual*, which you can download from the ARM website (infocenter.arm.com).

Embedded Trace FIFO (ETF)

The output of the Trace Funnel is sent to the ETF. The ETF is used as an elastic buffer between trace generators (STM, PTM) and trace destinations. The ETF stores up to 32 KB of trace data in the on-chip trace RAM.

AMBA Trace Bus Replicator (Replicator)

The Replicator broadcasts trace data from the ETF to the embedded trace router (ETR) and trace port interface unit (TPIU).



For more information, refer to the *CoreSight Components Technical Reference Manual*, which you can download from the ARM website (infocenter.arm.com).

Embedded Trace Router (ETR)

The ETR can route trace data to the HPS on-chip RAM, the HPS SDRAM, and any memory in the FPGA fabric connected to the HPS-to-FPGA bridge. The ETR receives trace data from the Replicator. By default, the buffer to receive the trace data resides in SDRAM at offset 0x00100000 and is 32 KB. You can override this default configuration by programming registers in the ETR.

Trace Port Interface Unit (TPIU)

The TPIU is a bridge between on-chip trace sources and an off-chip trace port. The TPIU receives trace data from the Replicator and drives the trace data to a trace port analyzer.

The trace output from the TPIU is software programmable and can be set to either 8 or 32 bits wide. The trace output is routed to an 8-bit HPS I/O interface and a 32-bit interface to the FPGA fabric. The trace data sent to the FPGA fabric can be transported off-chip using available serializer/deserializer (SERDES) resources in the FPGA.



For more information, refer to the *CoreSight Components Technical Reference Manual*, which you can download from the ARM website (infocenter.arm.com).

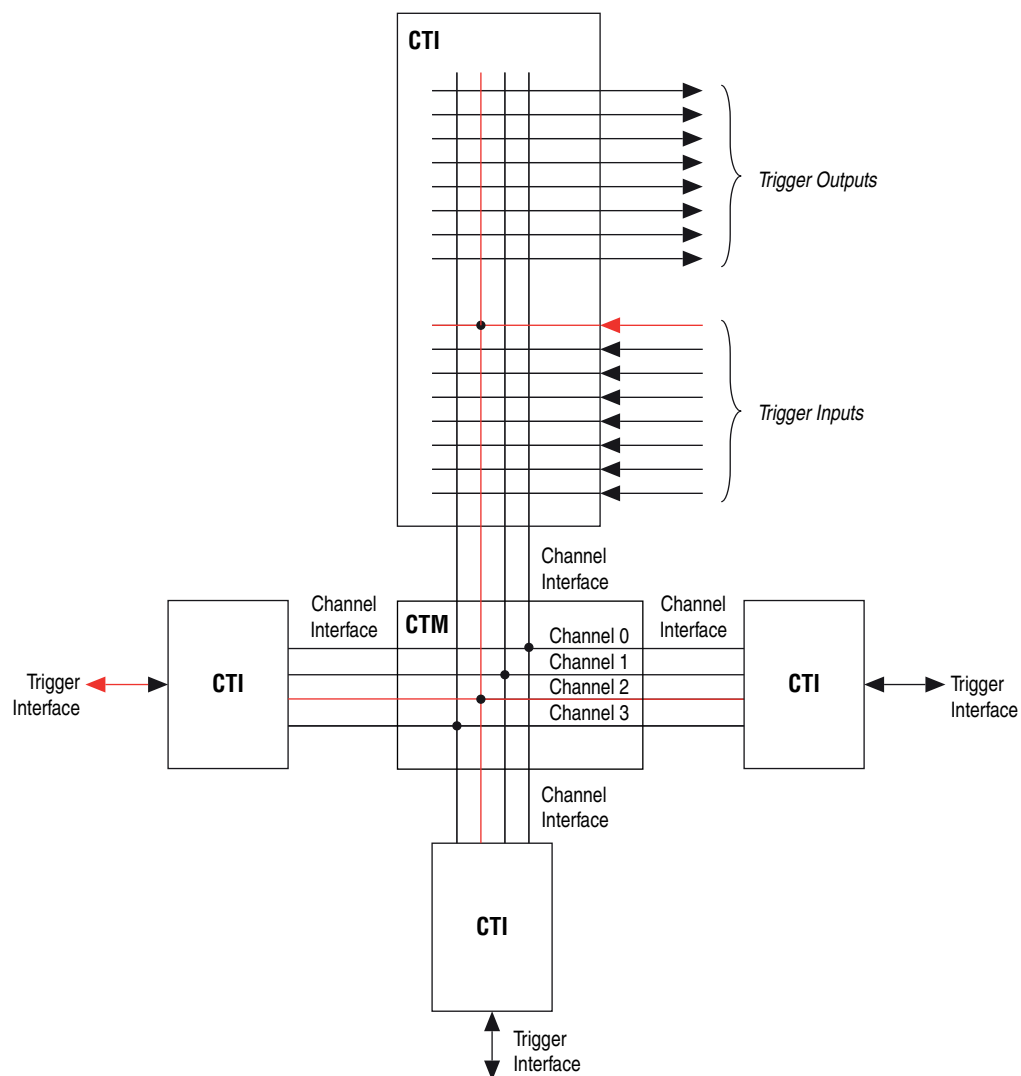
Embedded Cross Trigger (ECT) System

The ECT system provides a mechanism for HPS modules to trigger each other. The ECT consists of the following modules:

- Cross Trigger Interface (CTI)
- Cross Trigger Matrix (CTM)

Figure 7-2 shows how CTIs and CTMs are used in a generic ECT setup. The red line depicts an trigger input to one CTI generating a trigger output in another CTI. Though the signal travels throughout channel 2, it only enters and exits through trigger inputs and outputs you configure.

Figure 7-2. Generic ECT System



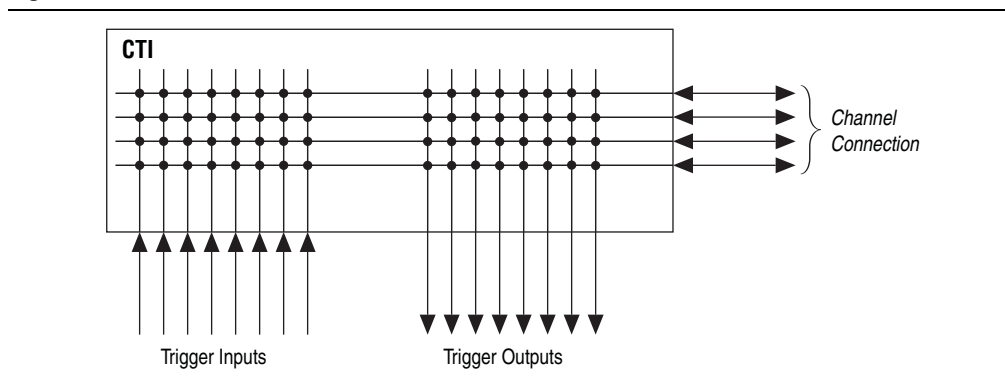
Cross Trigger Interface (CTI)

CTIs allow trigger sources and sinks to interface with the ECT. Each CTI supports up to eight trigger inputs and eight trigger outputs, and is connected to a CTM.

Figure 7-2 shows the relationship of trigger inputs, trigger outputs, and CTM channels of a CTI.

Figure 7-3 shows trigger input and trigger output connections in detail.

Figure 7-3. CTI Connections



The HPS debug system contains the following four CTIs:

- csCTI—performs cross triggering between the STM, ETF, ETR, and TPIU.
- FPGA-CTI—exposes the cross-triggering system to the FPGA fabric.
- CTI-0 and CTI-1—reside in the MPU debug subsystem. Each CTI is associated with a processor and the processor's associated PTM.

Cross Trigger Matrix (CTM)

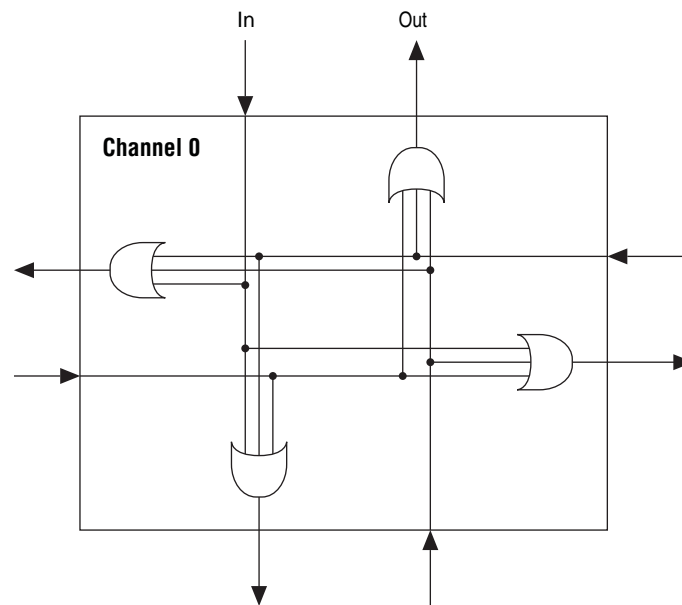
A CTM is a transport mechanism for triggers traveling from one CTI to one or more CTIs or CTMs. The HPS contains two CTMs. One CTM connects csCTI and FPGA-CTI; the other connects CTI-0 and CTI-1. The two CTMs are connected together, allowing triggers to be transmitted between the MPU debug subsystem, the debug system, and the FPGA fabric.

Each CTM has four ports and each port has four channels. Each CTM port can be connected to a CTI or another CTM.

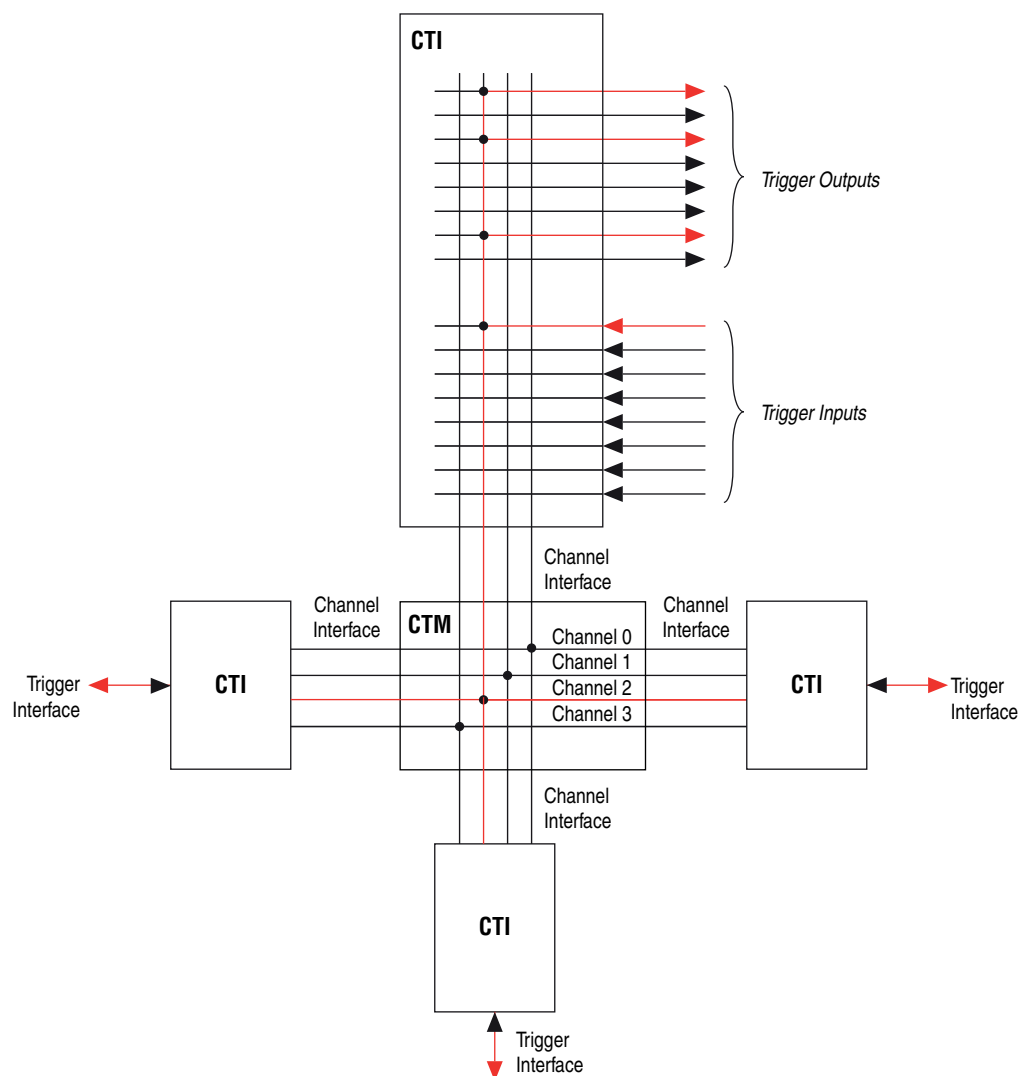
Figure 7-4 shows the structure of a CTM channel. Paths inside the CTM are purely combinatorial.

Each CTI trigger input can be connected through a CTM to one or more trigger

Figure 7-4. CTM Channel Structure



outputs under control by a debugger. Figure 7-5 shows a pictorial representation of CTI trigger connections. The red lines depict the impact one trigger input can have on the entire system.

Figure 7-5. CTI Trigger Connections

For more information, refer to the *CoreSight Components Technical Reference Manual*, which you can download from the ARM website (infocenter.arm.com).

Program Trace Macrocell (PTM)

The PTM performs real-time program flow instruction tracing and provides a variety of filters and triggers that can be used to trace specific portions of code.

The HPS contains two PTMs. Each PTM is paired with a processor and CTI. Trace data generated from the PTM can be transmitted off-chip using HPS pins, or to the FPGA fabric, where it can be pre-processed and transmitted off-chip using high-speed FPGA pins.

For more information, refer to the *CoreSight PTM-A9 Technical Reference Manual*, which you can download from the ARM website (infocenter.arm.com).

HPS Debug APB Interface

The HPS can extend the CoreSight debug control bus into the FPGA fabric. The debug interface is an APB-compatible interface with built-in clock crossing.



For more information, refer to the *HPS Component Interfaces* chapter in volume 3 of the *Cyclone V Device Handbook*.

CoreSight Debug and Trace Programming Model

This section describes programming model details specific to Altera's implementation of the ARM CoreSight technology.



For programming interface details of each CoreSight component, refer to the *CoreSight Components Technical Reference Manual*, which you can download from the ARM website (infocenter.arm.com).

The debug components can be configured to cause triggers when certain events occur. For example, soft logic in the FPGA fabric can signal an event which triggers an STM message injection into the trace stream. CoreSight components are configured through memory-mapped registers, located at offsets relative to the CoreSight component base address. CoreSight component base addresses are accessible through a ROM table.

ROM Table

Table 7-1 contains entries found in the ROM table portion of the DAP.

Table 7-1. DAP ROM Table

ROM Entry	Offset[30:12]	Description
0x0	0x00001	ETF
0x1	0x00002	CTI
0x2	0x00003	TPIU
0x3	0x00004	Trace Funnel
0x4	0x00005	STM
0x5	0x00006	ETR
0x6	0x00007	FPGA-CTI
0x7	0x00100	A9ROM
0x8	0x00080	FPGAROM
0x9	0x00000	End of ROM

A host debugger can access this table at 0x8000_0000 through the DAP. HPS masters can access this ROM at 0xFF00_0000. Registers for a particular CoreSight component are accessed by adding the register offset to the CoreSight component base address, and adding that total to the base address of the ROM table.

The base address of the ROM table is different when accessed from the debugger (at 0x8000_0000) than when accessed from any HPS master (at 0xFF00_0000). For example, the CTI output enable register, CTIOUTEN[2] at offset 0xA8, can be accessed by the host debugger at 0x8000_20A8. To derive that value, add the host debugger access address to the ROM table of 0x8000_0000, to the CTI component base address of 0x0000_2000, to the CTIOUTEN[2] register offset of 0xA8.

STM Channels

The STM AXI slave is connected to the MPU, DMA, and FPGA-to-HPS bridge masters. Each master has up to 65536 channels where each channel occupies 256 bytes of address space, for a total of 16 MB per master. The HPS address map allocates 48 MB of consecutive address space to the STM AXI slave port, divided in three 16 MB segments.

Table 7-2 lists the address allocation for the STM address segments.

Table 7-2. STM AXI Slave Port Address Allocation

Segment	Start Address	End Address
0	0xFC00_0000	0xFCFF_FFFF
1	0xFD00_0000	0xFDFF_FFFF
2	0xFE00_0000	0xFEFF_FFFF

Each of the three masters can access any one of the three address segments. Your software design determines which master uses which segment, based on the value of bits 24 and 25 in the write address, AWADDRS[25:24]. Software must restrict each master to use only one of the three segments.

Table 7-3 lists the fields of the STM address.

Table 7-3. STM AXI Address Fields

AXI Signal Fields	Description
AWADDRS[7:0]	These bits index the 256 bytes of the stimulus port. For more information, refer to the <i>System Trace Macrocell, Programmers' Model Architecture Specification</i> , which you can download from the ARM website (infocenter.arm.com).
AWADDRS[23:8]	These bits identify the 65536 stimulus ports associated with a master.
AWADDRS[25:24]	These bits identify the three masters. Only 0, 1, and 2 are valid values.
AWADDRS[31:26]	Always 0x3F. Bits 24 to 31 combine to access 0xFC00_0000 through 0xFEFF_FFFF.

Each STM message contains a master ID that tells the host debugger which master is associated with the message. The STM master ID is determined by combining a portion of the AWADDRS signal and the AWPROT protection bit. Table 7-4 shows how the STM master ID is calculated.

Table 7-4. STM Master ID Calculation

Master ID Bits	AXI Signal Bits	Notes
Master ID[5:0]	AWADDRS[29:24]	The lowest two bits are sufficient to determine which master, but CoreSight uses a seven-bit master ID.
Master ID[6]	AWPROT[1]	0 indicates secure; 1 indicates nonsecure.

In addition to access through STM channels, the higher-order 28 (31:4) of the 32 event signals are attached to the FPGA through the FPGA-CTI. These event signals allow the FPGA fabric to send additional messages using the STM.

CTI Trigger Connections to Outside the Debug System

The following CTIs in the HPS debug system connect to outside the debug system:

- csCTI
- FPGA-CTI

csCTI

This section lists the trigger input, output, and output acknowledge pin connections implemented for csCTI in the debug system. The trigger input acknowledge signals are not connected to pins.

Table 7-5 lists the trigger input pin connections implemented for csCTI.

Table 7-5. Trigger Input Signals

Number	Signal	Source
7	ASYNCOUT	STM
6	TRIGOUTHETE	STM
5	TRIGOUTSW	STM
4	TRIGOUTSPTE	STM
3	ACQCOMP	ETR
2	FULL	ETR
1	ACQCOMP	ETF
0	FULL	ETF

Table 7-6 lists the trigger output pin connections implemented for csCTI.

Table 7-6. Trigger Output Signals

Number	Signal	Destination
7	TRIGIN	ETF
6	FLUSHIN	ETF
5	HWEVENTS[3:2]	STM
4	HWEVENTS[1:0]	STM
3	TRIGIN	TPIU
2	FLUSHIN	TPIU
1	TRIGIN	ETR
0	FLUSHIN	ETR

Table 7-7 lists the trigger output acknowledge pin connections implemented for csCTI.

Table 7-7. Trigger Output Acknowledge Signals

Number	Signal	Source
7	0	—
6	0	—
5	0	—
4	0	—
3	TRIGINACK	TPIU
2	FLUSHINACK	TPIU
1	0	—
0	0	—

FPGA-CTI

FPGA-CTI connects the debug system to the FPGA fabric. FPGA-CTI has all of its triggers available to the FPGA fabric.

Configuring Embedded Cross-Trigger Connections

CTI interfaces are programmable through a memory-mapped register interface.



The specific registers are described in the *CoreSight Components Technical Reference Manual*, which you can download from the ARM website (infocenter.arm.com).

To access registers in any CoreSight component through the debugger, the register offsets must be added to the CoreSight component's base address. That combined value must then be added to the address at which the ROM table is visible to the debugger (0x80000000).

Each CTI has two interfaces, the trigger interface and the channel interface. The trigger interface is the interface between the CTI and other components. It has eight trigger signals, which are hardwired to other components. The channel interface is the interface between a CTI and its CTM, with four bidirectional channels. The mapping of trigger interface to channel interface (and vice versa) in a CTI is dynamically configured. You can enable or disable each CTI trigger output and CTI trigger input connection individually.

For example, you can configure trigger input 0 in the FPGA-CTI to route to channel 3, and configure trigger output 3 in the FPGA-CTI and trigger output 7 in CTI-0 in the MPU debug subsystem to route from channel 3. This configuration causes a trigger at trigger input 0 in FPGA-CTI to propagate to trigger output 3 in the FPGA-CTI and trigger output 7 in CTI-0. Propagation can be single-to-single, single-to-multiple, multiple-to-single, and multiple-to-multiple.

A particular soft logic signal in the FPGA connected to a trigger input in the FPGA-CTI can be configured to trigger a flush of trace data to the TPIU. For example, you can configure channel 0 to trigger output 2 in csCTI. Then configure trigger input T3 to channel 0 in FPGA-CTI. Trace data is flushed to the TPIU when a trigger is received at trigger output 2 in csCTI.

Another soft logic signal in the FPGA connected to trigger input T2 in FPGA-CTI can be configured to trigger an STM message. csCTI output triggers 4 and 5 are wired to the STM CoreSight component in the HPS. For example, configure channel 1 to trigger output 4 in csCTI. Then configure trigger input T2 to channel 1 in FPGA-CTI. Refer to [Figure 7-1](#).

Another soft logic signal in the FPGA fabric connected to trigger input T1 in FPGA-CTI can be configured to trigger a breakpoint on CPU 1. Trigger output 1 in CTI-1 is wired to the debug request (EDBGRQ) signal of CPU-1. For example, configure channel 2 to trigger output 1 in CTI-1. Then configure trigger input T1 to channel 2 in FPGA-CTI.

Debug Clocks

The CoreSight system uses several different clocks. [Table 7-8](#) provides a list of these clocks. Port Name is the name of the clock signal inputs described for individual CoreSight debug components in the ARM documentation. Signal Name is the name of the clock signal used with other HPS components.

Table 7-8. CoreSight Clocks

Port Name	Clock Source	Signal Name	Description
ATCLK	Clock manager	dbg_at_clk	Trace bus clock.
CTICLK (for csCTI)	Clock manager	dbg_at_clk	Cross trigger interface clock for csCTI. It can be synchronous or asynchronous to CTMCLK.
CTICLK (for FPGA-CTI)	FPGA fabric	fpga_cti_clk	Cross trigger interface clock for FPGA-CTI.
CTICLK (for CTI-0 and CTI-1)	Clock manager	mpu_clk	Cross trigger interface clock for CTI-0 and CTI-1. It can be synchronous or asynchronous to CTMCLK.
CTMCLK (for csCTM)	Clock manager	dbg_clk	Cross trigger matrix clock for csCTM. It can be synchronous or asynchronous to CTICLK.
CTMCLK (for CTM)	Clock manager	mpu_clk	Cross trigger matrix clock for CTM. It can be synchronous or asynchronous to CTICLK.
DAPCLK	Clock manager	dbg_clk	DAP internal clock. It must be equivalent to PCLKDBG.
PCLKDBG	Clock manager	dbg_clk	Debug APB (DAPB) clock.
HCLK	Clock manager	dbg_clk	Used by the AHB-Lite master inside the DAP. It is asynchronous to DAPCLK. In the HPS, the AHB-Lite port uses same clock as DAPCLK.
PCLKSYS	Clock manager	l4_mp_clk	Used by the APB slave port inside the DAP. It is asynchronous to DAPCLK.
SWCLKTCK	JTAG interface	dap_tck	The SWJ-DP clock driven by the external debugger through either the JTAG interface or the FPGA fabric. It is asynchronous to DAPCLK. When through the JTAG interface, this clock is the same as TCK of the JTAG interface.
	FPGA fabric	tpiu_traceclk_in	
TRACECLKIN	Clock manager	dbg_trace_clk	TPIU trace clock input. It is asynchronous to ATCLK. In the HPS, this clock can come from the clock manager or the FPGA fabric.




For more information about the CoreSight port names, refer to table 6-2 in the *CoreSight Technology System Design Guide*, which you can download from the ARM website (infocenter.arm.com).

Debug Resets


The CoreSight system uses several resets. Table 7-9 provides a list of these resets. Port Name is the name of the clock signal inputs described for individual CoreSight debug components in the ARM documentation. Signal Name is the name of the clock signal used with other HPS components.

Table 7-9. CoreSight Resets

Port Name	Clock Source	Signal Name	Description
ATRESETn	Reset manager	dbg_rst_n	Trace bus reset. It resets all registers in ATCLK domain.
nCTIRESET	Reset manager	dbg_rst_n	CTI reset signal. It resets all registers in CTICLK domain. In the HPS, there are four instances of CTI. All four use the same reset signal.
DAPRESETn	Reset manager	dbg_rst_n	DAP internal reset. It is connected to PRESETDBGn.
PRESETDBGn	Reset manager	dbg_rst_n	Debug APB reset. Resets all registers clocked by PCLKDBG.
HRESETn	Reset manager	sys_dbg_rst_n	SoC-provided reset signal that resets all of the AMBA on-chip interconnect. Use this signal to reset the DAP AHB-Lite master port.
PRESETSYSn	Reset manager	sys_dbg_rst_n	Resets system APB slave port of DAP.
nCTMRESET	Reset manager	dbg_rst_n	CTM reset signal. It resets all signals clocked by CTMCLK.
nPOTRST	Reset manager	tap_cold_rst_n	True power on reset signal to the DAP SWJ-DP. It must only reset at power-on.
nTRST	JTAG interface	nTRST pin	Resets the DAP TAP controller inside the SWJ-DP. This signal is driven by the host using the JTAG connector.
TRESETn	Reset manager	dbg_rst_n	Reset signal for TPIU. Resets all registers in the TRACECLKIN domain.

 For more information about the CoreSight port names, refer to table 6-3 in the *CoreSight Technology System Design Guide*, which you can download from the ARM website (infocenter.arm.com).

The ETR stall enable field (etrstallen) of the ctrl register in the reset manager controls whether the ETR is requested to stall its AXI master interface to the L3 interconnect before a warm or debug reset.

 For more information about reset handshaking, refer to the *Reset Manager* chapter in volume 3 of the *Cyclone V Device Handbook*.

The level 4 (L4) watchdog timers can be paused during debugging to prevent reset while the processor is stopped at a breakpoint.

 For more information, refer to the *Watchdog Timer* chapter in volume 3 of the *Cyclone V Device Handbook*.


CoreSight Debug and Trace Address Map and Register Definitions

 The address map resides in the [hps.html](#) file that accompanies this handbook volume. The register definitions reside in separate ARM documentation. Click the link to open the file.

To view the debug-related module descriptions and base addresses, scroll to and click the following links:

- [stm](#)
- [dap](#)
- [dmanonsecure](#)
- [dmasecure](#)
- [mpuscu](#)
- [mpul2](#)

To then view the register and field descriptions, click the link in the module description to access the appropriate ARM documentation. The register addresses are offsets relative to the base address of each module instance.

 The base addresses of all modules are also listed in the [Introduction to the Hard Processor System](#) chapter in volume 3 of the *Cyclone V Device Handbook*.

Document Revision History

[Table 7-10](#) shows the revision history for this document.

Table 7-10. Document Revision History

Date	Version	Changes
November 2012	1.2	Minor updates.
June 2012	1.1	Added functional description, programming model, and address map and register definitions sections.
January 2012	1.0	Initial release.

This section includes the following chapters:

- Chapter 8, SDRAM Controller Subsystem
- Chapter 9, On-Chip Memory
- Chapter 10, NAND Flash Controller
- Chapter 11, SD/MMC Controller
- Chapter 12, Quad SPI Flash Controller



For information about the revision history for chapters in this section, refer to “Document Revision History” in each individual chapter.

The hard processor system (HPS) SDRAM controller subsystem provides efficient access to external SDRAM for the ARM® Cortex™-A9 microprocessor unit (MPU) subsystem, the level 3 (L3) interconnect, and the FPGA fabric. The SDRAM controller provides an interface between the FPGA fabric and HPS. The interface accepts Advanced Microcontroller Bus Architecture (AMBA®) Advanced eXtensible Interface (AXI™) and Avalon® Memory-Mapped (Avalon-MM) transactions, converts those commands to the correct commands for the SDRAM, and manages the details of the SDRAM access.

Features of the SDRAM Controller Subsystem

The SDRAM controller subsystem offers the following features:

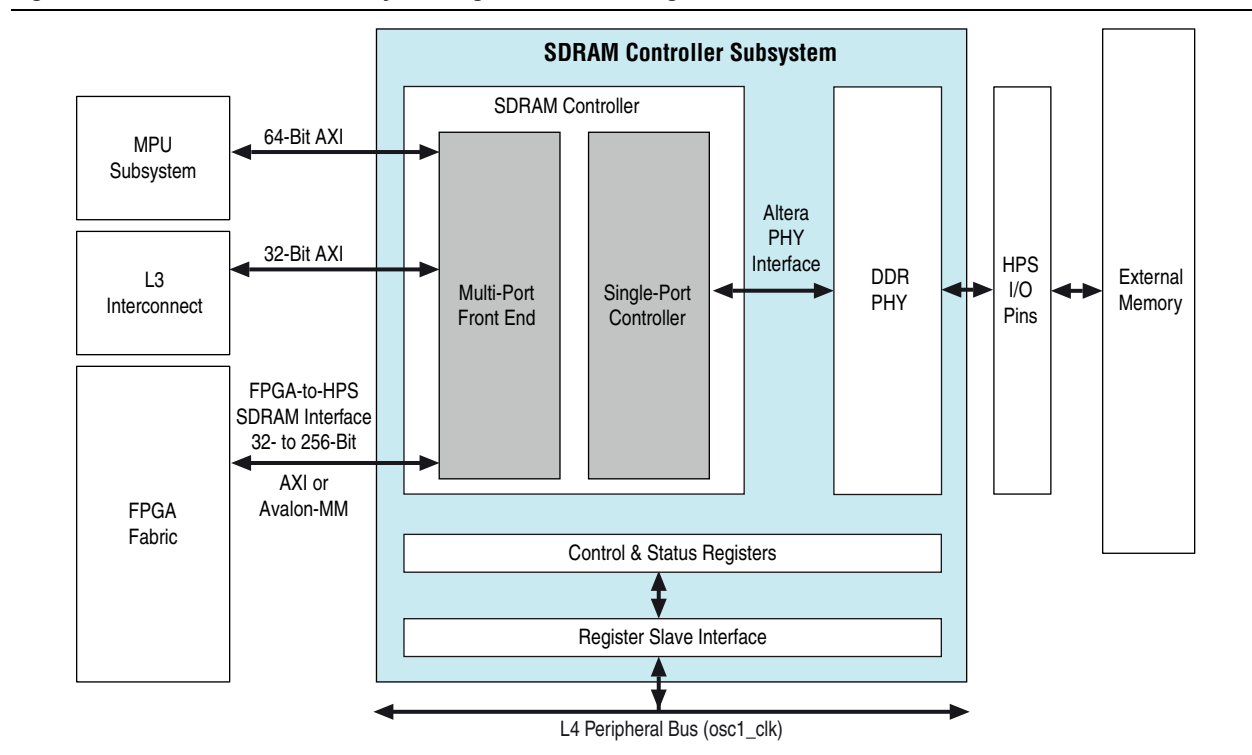
- Support for double data rate 2 (DDR2), DDR3, and low-power DDR2 (LPDDR2) SDRAM
- User-configurable timing parameters
- Up to 4 Gb density parts
- Two chip selects
- Integrated error correction code (ECC), 24- and 40-bit widths
- User-configurable memory width of 8, 16, 16+ECC, 32, 32+ECC
- Command reordering (look-ahead bank management)
- Data reordering (out of order transactions)
- User-controllable bank policy on a per port basis for either closed page or conditional open page accesses
- User-configurable priority support with both absolute and relative priority scheduling
- Flexible FPGA fabric interface configuration with up to 6 ports and data widths up to 256 bits wide using Avalon-MM and AXI interfaces.
- Power management supporting self refresh, partial array self-refresh (PASR), power down, and LPDDR2 deep power down

SDRAM Controller Subsystem Block Diagram and System Integration

The SDRAM controller subsystem connects to the MPU subsystem, the main switch of the L3 interconnect, and the FPGA fabric. The memory interface consists of the SDRAM controller, the physical layer (PHY), control and status registers, and their associated interfaces.

Figure 8–1 shows a high-level block diagram of the SDRAM controller subsystem.

Figure 8–1. SDRAM Controller Subsystem High-Level Block Diagram



SDRAM Controller

The SDRAM controller provides high performance data access and run-time programmability. The controller reorders data to reduce row conflicts and bus turn-around time by grouping read and write transactions together, allowing for efficient traffic patterns and reduced latency.

The SDRAM controller consists of a multiport front end (MPFE) and a single-port controller. The MPFE provides multiple independent interfaces to the single-port controller. The single-port controller communicates with and manages each external memory device. For more information, refer to “[Memory Controller Architecture](#)” on page 8–4.

DDR PHY

The DDR PHY provides a physical layer interface between the memory controller and memory devices, which performs read and write memory operations. The DDR PHY has dataflow components, control components, and calibration logic that handle the calibration for the SDRAM interface timing.

SDRAM Controller Subsystem Interfaces

The following sections describe the SDRAM controller subsystem interfaces.

MPU Subsystem Interface

The SDRAM controller is connected to the MPU subsystem with a dedicated 64-bit AXI interface, operating on the `mpu_l2_ram_clk` clock domain.

L3 Interconnect Interface

The SDRAM controller is connected to the L3 interconnect with a dedicated 32-bit AXI interface, operating on the `l3_main_clk` clock domain.

CSR Interface

The CSR interface is connected to the level 4 (L4) bus and operates on the `l4_sp_clk` clock domain. The MPU subsystem uses the CSR interface to configure the controller and PHY, for example, setting the memory timing parameter values or placing the memory to a low power state. The CSR interface also provides access to the status registers in the controller and PHY.

FPGA-to-HPS SDRAM Interface

The FPGA-to-HPS SDRAM interface provides masters implemented in the FPGA fabric access to the SDRAM controller subsystem in the HPS. The interface has three ports types that are used to construct the following AXI or Avalon-MM interfaces:

- Command ports—issue read and write commands, and for receive write acknowledge responses
- 64-bit read data ports—receive data returned from a memory read
- 64-bit write data ports—transmit write data

The FPGA-to-HPS SDRAM interface supports six command ports, allowing up to six Avalon-MM interfaces or three AXI interfaces. Each command port can be used to implement either a read or write command port for AXI, or be used as part of an Avalon-MM interface. The AXI and Avalon-MM interfaces can be configured to support 32-, 64-, 128-, and 256-bit data.

Table 8–1 lists the FPGA-to-HPS SDRAM controller interface ports connected to the FPGA.

Table 8–1. FPGA-to-HPS SDRAM Controller Port Types

Port Type	Number
Command	6
64-bit read data	4
64-bit write data	4

The FPGA-to-HPS SDRAM controller interface can be configured with the following characteristics:

- Avalon-MM interfaces and AXI interfaces can be mixed and matched as required by the fabric logic, within the bounds of the number of ports provided to the fabric.

- Each Avalon-MM or AXI interface of the FPGA-to-HPS SDRAM interface operates on an independent clock domain.
- The FPGA-to-HPS SDRAM interfaces are configured during FPGA configuration.

Table 8–2 shows the number of ports needed to configure different bus protocols, based on type and data width.

Table 8–2. FPGA-to-HPS SDRAM Port Utilization

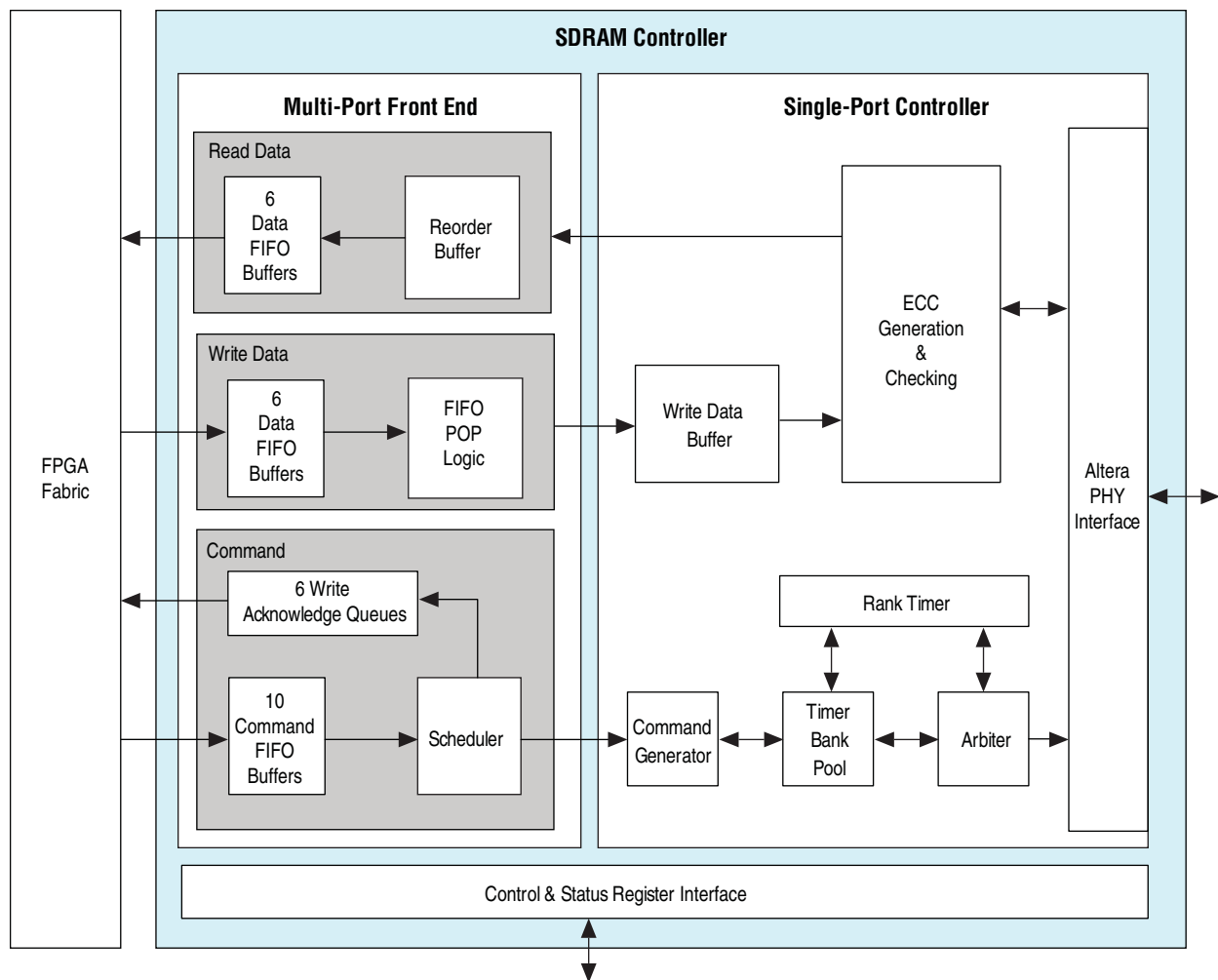
Bus Protocol	Command	Read Data	Write Data
32- or 64-bit AXI	2 ⁽¹⁾	1	1
128-bit AXI	2 ⁽¹⁾	2 ⁽²⁾	2 ⁽²⁾
256-bit AXI	2 ⁽¹⁾	4 ⁽²⁾	4 ⁽²⁾
32- or 64-bit Avalon-MM	1	1	1
128-bit Avalon-MM	1	2	2
256-bit Avalon-MM	1	4	4
32- or 64-bit Avalon-MM write-only	1	0	1
128-bit Avalon-MM write-only	1	0	2
256-bit Avalon-MM write-only	1	0	4
32- or 64-bit Avalon-MM read-only	1	1	0
128-bit Avalon-MM read-only	1	2	0
256-bit Avalon-MM read-only	1	4	0
Notes to Table 8–2: (1) Because the AXI protocol allows simultaneous read and write commands to be issued, two SDRAM control ports are required to form an AXI interface. (2) Because the native size of the data ports is 64 bits, extra read and write ports are required to form an AXI interface.			

Memory Controller Architecture

The SDRAM controller consists of an MPFE, a single-port controller, and an interface to the CSRs.

Figure 8–2 shows a block diagram of the SDRAM controller portion of the SDRAM controller subsystem.

Figure 8–2. SDRAM Controller Block Diagram



MPFE

The MPFE is responsible for scheduling pending transactions from the configured interfaces and sending the scheduled memory transactions to the single-port controller. The MPFE handles all functions related to individual ports.

The MPFE consists of the following three primary sub-blocks.

Command Block

The command block accepts read and write transactions from the FPGA fabric and the HPS. When the command FIFO buffer is full, the command block applies backpressure by deasserting the ready signal. For each pending transaction, the command block calculates the next SDRAM burst needed to progress on that transaction. The command block schedules pending SDRAM burst commands based on the user-supplied configuration, available write data, and unallocated read data space.

Write Data Block

The write data block transmits data to the single-port controller. The write data block maintains write data FIFO buffers and clock boundary crossing for the write data. The write data block informs the command block of the amount of pending write data for each transaction so that the command block can calculate eligibility for the next SDRAM write burst.

Read Data Block

The read data block receives data from the single-port controller. Depending on the port state, the read data block either buffers the data in its internal buffer or passes the data straight to the clock boundary crossing FIFO buffer. The read data block reorders out-of-order data for Avalon-MM ports.

In order to prevent the read FIFO buffer from overflowing, the read data block informs the command block of the available buffer area so the command block can pace read transaction dispatch.

Single-Port Controller

The single-port logic is responsible for following actions:

- Queuing the pending SDRAM bursts
- Choosing the most efficient burst to send next
- Keeping the SDRAM pipeline full
- Ensuring all SDRAM timing parameters are met

Transactions passed to the single-port logic for a single page in SDRAM are guaranteed to be executed in order, but transactions can be reordered between pages. Each SDRAM burst read or write is converted to the appropriate Altera PHY interface (AFI) command to open a bank on the correct row for the transaction (if required), execute the read or write command, and precharge the bank (if required).

The single-port logic implements command reordering (looking ahead at the command sequence to see which banks can be put into the correct state to allow a read or write command to be executed) and data reordering (allowing data transactions to be dispatched even if the data transactions are executed in an order different than they were received from the multiport logic).

Command Generator

The command generator accepts commands from the MPFE and from the internal ECC logic, and provides those commands to the timer bank pool.

Timer Bank Pool

The timer bank pool is a parallel queue that operates with the arbiter to enable data reordering. The timer bank pool tracks incoming requests, ensures that all timing requirements are met, and, on receiving write-data-ready notifications from the write data buffer, passes the requests to the arbiter.

Arbiter

The arbiter determines the order in which requests are passed to the memory device. When the arbiter receives a single request, that request is passed immediately. When multiple requests are received, the arbiter uses arbitration rules to determine the order to pass requests to the memory device.

Rank Timer

The rank timer performs the following functions:

- Maintains rank-specific timing information
- Ensures that only four activates occur within a specified timing window
- Manages the read-to-write and write-to-read bus turnaround time
- Manages the time-to-activate delay between different banks

Write Data Buffer

The write data buffer receives write data from the MPFE and passes the data to the PHY, on approval of the write request.

ECC Block

The ECC block consists of an encoder and a decoder-corrector, which can detect and correct single-bit errors, and detect double-bit errors. The ECC block can correct single-bit errors and detect double-bit errors resulting from noise or other impairments during data transmission.

AFI Interface

The AFI interface provides communication between the controller and the PHY.

CSR Interface

The CSR interface is accessible from the L4 bus. The interface allows code executing in the HPS MPU and FPGA fabric to configure and monitor the SDRAM controller.

Functional Description of the SDRAM Controller Subsystem

This section provides a functional description of the SDRAM controller subsystem.

MPFE Operational Behavior

This section describes the operational behavior of the MPFE.

Operation Ordering

Requests to the same SDRAM page arriving at a given port are executed in the order in which they are received. Requests arriving at different ports have no guaranteed order of service, except when a first transaction has completed before the second arrives.

Operation ordering is defined and enforced within a port, but not between ports. All transactions received on a single port for overlapping addresses execute in order. Transactions received on different ports have no guaranteed order unless the second transaction is presented after the first has completed.

Avalon-MM does not support write acknowledgement. When a port is configured to support Avalon-MM, you should read from the location that was previously written to ensure that the write operation has completed. When a port is configured to support AXI, the master accessing the port can safely issue a read operation to the same address as a write operation as soon as the write has been acknowledged. To keep write latency low, writes are acknowledged as soon as the transaction order is guaranteed—meaning that any operations received on any port to the same address as the write operation are executed after the write operation.

To ensure that the overall latency of traffic is as low as possible, the single port logic can return read data out of order to the multi-port logic which will reorder it when transactions return out of order. A large percentage of traffic reordering will be between ports and transactions only are ordered within a port. For traffic which is reordered between ports but not within a port, no reordering needs to be done. Eliminating unnecessary reordering reduces average latency.

Multiport Scheduling

Multiport scheduling is governed by two factors, the absolute priority of a request and the weighting of a port.

The evaluation of absolute priority ensures that ports carrying higher-priority traffic are served ahead of ports carrying lower-priority traffic. The scheduler recognizes eight priority levels (0-7), with higher values representing higher priorities. For example, any transaction with priority seven is scheduled before transactions of priority six or lower.

When ports carry traffic of the same absolute priority, relative priority is determined based on port weighting. Port weighting is a five-bit value (0-31), and is determined by a deficit-weighted round robin (DWRR) algorithm, which corrects for past over-servicing or under-servicing of a port. Each port has an associated weight which is updated every cycle, with a user-configured weight added to it and the amount of traffic served subtracted from it. The port with the highest weighting is considered the most eligible.

To ensure that high-priority traffic is served quickly and that long and short bursts are effectively interleaved between ports, incoming transactions longer than a single SDRAM burst are scheduled as a series of SDRAM bursts, with each burst arbitrated separately.

To ensure that lower priority ports do not build up large running weights while higher priority ports monopolize bandwidth, the controller's DWRR weights are updated only when a port matches the scheduled priority. Therefore, if three ports are being accessed, two being priority seven and one being priority four, the weights for both ports at priority seven are updated but the port with priority four remains unchanged.

Multiport scheduling is performed between all of the ports connected to the FPGA fabric and internally in the HPS to determine which transaction is serviced next. Arbitration is performed on a SDRAM burst basis to ensure that a long transaction does not lock other transactions or cause latency to significantly increase for high-priority ports.

Arbitration supports both absolute and relative priority. Absolute priority is intended for applications where one master should always get priority above or below others. Relative priority is supported through a programmable weight field which controls scheduling between ports at the same priority.

The scheduler is work-conserving. Write operations can only be scheduled when enough data for the SDRAM burst has been received. Read operations can only be scheduled when sufficient internal memory is free and the port is not occupying too much of the read buffer.

The multiport scheduling configuration can be updated while traffic is flowing. Both priority and weight for a port can be updated without interrupting traffic on a port. Updates are used in scheduling decisions within 10 memory clock cycles of being updated, so priority can be updated frequently if needed.

Read Data Handling

The MPFE contains a read buffer shared by all ports. If a port is capable of receiving returned data then the read buffer is bypassed. If the size of a read transaction is smaller than twice the memory interface width, the buffer RAM cannot be bypassed.

SDRAM Burst Scheduling

SDRAM burst scheduling recognizes addresses that access the same row/bank combination, known as open page accesses. Operations to a page are served in the order in which they are received by the single-port controller.

Selection of SDRAM operations is a two-stage process. First, each pending transaction must wait for its timers to be eligible for execution. Next, the transaction arbitrates against other transactions that are also eligible for execution.

The following rules govern transaction arbitration:

- High-priority operations take precedence over lower-priority operations
- If multiple operations are in arbitration, read operations have precedence over write operations
- If multiple operations still exist, the oldest is served first

A high-priority transaction in the SDRAM burst scheduler wins arbitration for that bank immediately if the bank is idle and the high-priority transaction's chip select, row, or column fields of the address do not match an address already in the single-port controller. If the bank is not idle, other operations to that bank yield until the high-priority operation is finished. If the chip select, row, and column fields match an earlier transaction, the high-priority transaction yields until the earlier transaction is completed.

Clocking

The FPGA fabric ports of the MPFE can be clocked at different frequencies. Synchronization is maintained by clock-domain crossing logic in the MPFE. Command ports can operate on different clock domains, but the data ports associated with a given command port must be attached to the same clock as that command port. For example, a command port paired with a read and write port to form an Avalon-MM interface must operate at the same clock frequency as the data ports associated with it.

Single-Port Controller Operational Behavior

This section describes the operational behavior of the single-port controller.

SDRAM Interface

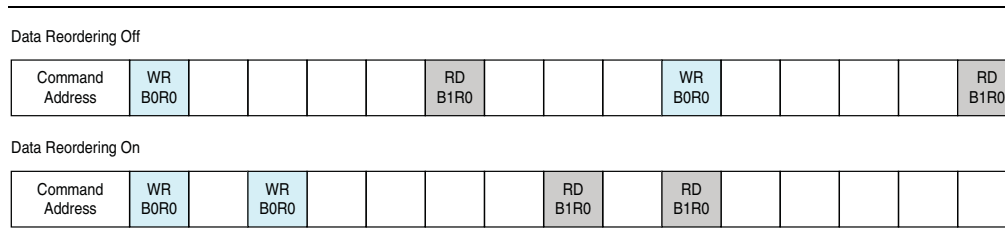
The SDRAM interface is up to 40 bits wide and can accommodate 8-bit, 16-bit, 16-bit plus ECC, 32-bit, or 32-bit plus ECC configurations. The SDRAM interface supports LPDDR2, DDR2, and DDR3 memory protocols.

Command and Data Reordering

The heart of the SDRAM controller is a command and data reordering engine. Command reordering allows banks for future transactions to be opened before the current transaction finishes. Data reordering allows transactions to be serviced in a different order than they were received when that new order allows for improved utilization of the SDRAM bandwidth. Operations to the same bank and row are performed in order to ensure that operations which impact the same address preserve the data integrity.

Figure 8-3 shows the relative timing for a write/read/write/read command sequence performed in order and then the same command sequence performed with data reordering. Data reordering allows the write and read operations to occur in bursts, without bus turnaround timing delay or bank reassignment.

Figure 8-3. Data Reordering Effect



The SDRAM controller schedules among all pending row and column commands every clock cycle.

Bank Policy

The bank policy of the SDRAM controller allows users to request that a transaction's bank remain open after an operation has finished so that future accesses do not delay in activating the same bank and row combination. The controller supports only eight simultaneously-opened banks, so an open bank might get closed if the bank resource is needed for other operations.

Open bank resources are allocated dynamically as SDRAM burst transactions are scheduled. Bank allocation is requested automatically by the controller when an incoming transaction spans multiple SDRAM bursts or by the extended command interface. When a bank must be reallocated, the least-recently-used open bank is used as the replacement.

If the controller determines that the next pending command will cause the bank request to not be honored, the bank might be held open or closed depending on the pending operation. A request to close a bank with a pending operation in the timer bank pool to the same row address causes the bank to remain open. A request to leave a bank open with a pending command to the same bank but a different row address causes a precharge operation to occur.

Write Combining

The SDRAM controller combines write operations from successive bursts on a port where the starting address of the second burst is one greater than the ending address of the first burst and the resulting burst length does not overflow the 11-bit burst-length counters. Write combining does not occur if the previous bus command has finished execution before the new command has been received.

Burst Length Support

The controller supports burst lengths of 2, 4, 8, and 16, and data widths of 8, 16, and 32 bits for non-ECC operation, and widths of 24 and 40 operations with ECC enabled. [Table 8-3](#) shows the type of SDRAM for each burst length.

Table 8-3. SDRAM Burst Lengths

Burst Length	SDRAM
4	LPDDR2, DDR2
8	DDR2, DDR3, LPDDR2
16	LPDDR2

Width Matching

The SDRAM controller automatically performs data width conversion.

ECC

The single-port controller supports memory ECC calculated by the controller. The controller ECC employs standard Hamming logic to detect and correct single-bit errors and detect double-bit errors. The controller ECC is available for 16-bit and 32-bit widths, each requiring an additional 8 bits of memory, resulting in an actual memory width of 24-bits and 40-bits, respectively.

Controller ECC provides the following features:

- **Byte writes**—The memory controller performs a read-modify-write operation to ensure that the ECC data remains valid when a subset of the bits of a word is being written. If an entire word is being written (but less than a full burst) and the DM pins are connected, no read is necessary and only that word is updated. If controller ECC is disabled, byte-writes have no performance impact.

- ECC write backs—When a read operation detects a correctable error, the memory location is scheduled for a read-modify-write operation to correct the single-bit error. ECC write backs are enabled and disabled through the `cfg_enable_ecc_code_overwrites` field in the `ctrlcfg` register.
- Notification of ECC errors—The memory controller provides interrupts for single-bit and double-bit errors. The status of interrupts and errors are recorded in status registers, as follows:
 - The `dramsts` register records interrupt status.
 - The `dramintr` register records interrupt masks.
 - The `sbecount` register records the single-bit error count.
 - The `dbecount` register records the double-bit error count.
 - The `erraddr` register records the address of the most recent error.

Byte Writes

Byte writes with ECC enabled are executed as a read-modify-write. Typical operations only use a single entry in the timer bank pool. Controller ECC enabled sub-word writes use two entries. The first operation is a read and the second operation is a write. These two operations are transferred to the timer bank pool with an address dependency so that the write cannot be performed until the read data has returned. This approach ensures that any subsequent operations to the same address (from the same port) are executed after the write operation, because they are ordered on the row list after the write operation.

If an entire word is being written (but less than a full burst), then no read is necessary and only that word is updated.

ECC Write Backs

If the controller ECC is enabled and a read operation results in a correctable ECC error, the controller corrects the location in memory, if write backs are enabled. The correction results in scheduling a new read-modify-write. A new read is performed at the location to ensure that a write operation modifying the location is not overwritten. The actual ECC correction operation is performed as a read-modify-write operation.

User Notification of ECC Errors

The following methods notify you of an ECC error:

For the MPU subsystem, an interrupt signal provides notification and the ECC error information is stored in the status registers.



For more information, refer to the *Cortex-A9 Microprocessor Unit SubSystem* chapter in volume 3 of the *Cyclone V Device Handbook*.

Interleaving Options

The controller supports the following address-interleaving options:

- Noninterleaved
- Bank interleave without chip select interleave
- Bank interleave with chip select interleave

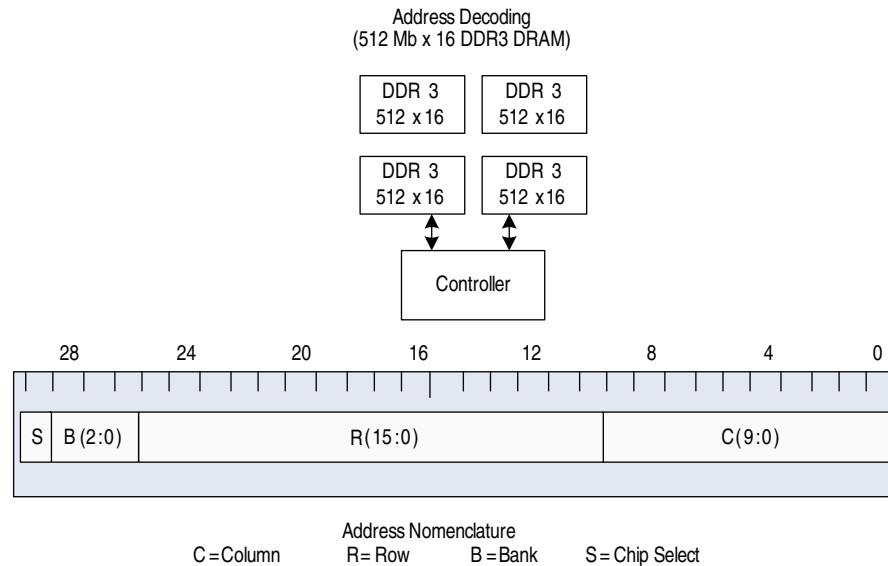
All of the interleaving examples use 512 megabits (Mb) x 16 DDR3 chips and are documented as byte addresses. For RAMs with smaller address fields, the order of the fields stays the same but the widths may change.

Noninterleaved

RAM mapping is noninterleaved.

Figure 8-4 shows noninterleaved address decoding.

Figure 8-4. Noninterleaved Address Decoding

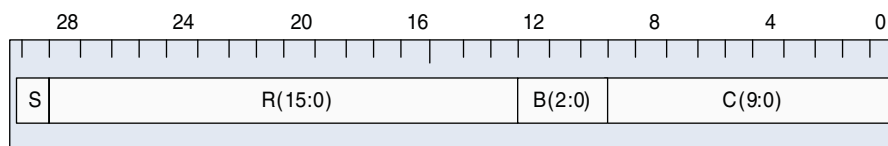


Bank Interleave Without Chip Select Interleave

Bank interleave without chip select interleave swaps row and bank from the noninterleaved address mapping. This interleaving allows smaller data structures to spread across all banks in a chip.

Figure 8-5 shows bank interleave without chip select interleave address decoding.

Figure 8-5. Bank Interleave Without Chip Select Interleave Address Decoding

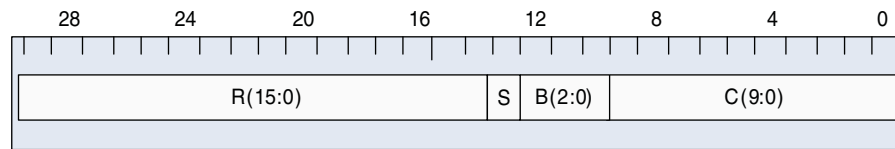


Bank Interleave with Chip Select Interleave

Bank interleave with chip select interleave moves the row address to the top, followed by chip select, then bank, and finally column address. This interleaving allows smaller data structures to spread across multiple banks and chips (giving access to 16 total banks for multithreaded access to blocks of memory). Memory timing is degraded when switching between chips.

Figure 8–6 shows bank interleave with chip select interleave address decoding.

Figure 8–6. Bank Interleave With Chip Select Interleave Address Decoding



AXI-Exclusive Support

The single-port controller supports AXI-exclusive operations. The controller implements a table shared across all masters, which can store up to 16 pending writes. Table entries are allocated on an exclusive read and table entries are deallocated on a successful write to the same address by any master.

Any exclusive write operation that is not present in the table returns an exclusive fail as acknowledgement to the operation. If the table is full when the exclusive read is performed, the table replaces a random entry.



When using AXI-exclusive operations, accessing the same location from Avalon-MM interfaces can result in unpredictable results.

Memory Protection

The single-port controller has address protection to allow the software to configure basic protection of memory from all masters in the system. If the system has been designed exclusively with AXI masters, TrustZone® is supported. Ports that use Avalon-MM can be configured for port level protection.



For information about TrustZone®, refer to the ARM website (www.arm.com).

Memory protection is based on physical addresses in memory. You can set rules to allow or disallow accesses to a range of memory, or to enable only secure accesses to a range of memory (or a combination of the two).

Secure and non-secure regions are specified by rules containing a starting address and ending address with 1 MB boundaries for both addresses. You can override the port defaults and allow or disallow all transactions.

The memory protection table, which is an internal table addressed through the CSR interface, contains rules to permit or deny memory access. You can configure up to a maximum of twenty rules to control memory access. Table 8–4 lists the fields that you can specify for each rule.

Table 8–4. Fields for Rules in Memory Protection Table (Part 1 of 2)

Field	Width	Description
Valid	1	Set to 1 to activate the rule. Set to 0 to deactivate the rule.
Port Mask ⁽¹⁾	10	Specifies the set of ports to which the rule applies, with one bit representing each port, as follows: bits 0 to 5 correspond to FPGA fabric ports 0 to 5, bit 6 corresponds to AXI L3 switch read, bit 7 is the CPU read, bit 8 is L3 switch write, and bit 9 is the CPU write.

Table 8-4. Fields for Rules in Memory Protection Table (Part 2 of 2)

Field	Width	Description
TID_low ⁽¹⁾	12	Low transfer ID of the rules to which this rule applies. Incoming transactions match if they are greater than or equal to this value. Ports with smaller TIDs have the TID shifted to the lower bits and zero padded at the top.
TID_high ⁽¹⁾	12	High transfer ID of the rules to which this rule applies. Incoming transactions match if they are less than or equal to this value.
Address_low	12	Points to a 1MB block and is the lower address. Incoming addresses match if they are greater than or equal to this value.
Address_high	12	Upper limit of address. Incoming addresses match if they are less than or equal to this value.
Protection	2	A value of 00 indicates that the protection bit is not set; a value of 01 sets the protection bit. Systems that do not set AXI protection to a known value should program this for either protection value.
Fail/allow	1	Set this value to 1 to force the operation to fail or succeed.

Note to Table 8-4:

- (1) Although TID and Port Mask could be redundant, including both in the table allows possible compression of rules. If masters connected to a port do not have contiguous TIDs, a port-based rule might be more efficient than a TID-based rule, in terms of the number of rules needed.

A port has a default access status of either allow or fail, and rules with the opposite allow/fail value can override the default. The system evaluates each transaction against every rule in the memory protection table. A transaction received on a port which by default allows access, would fail only if a rule with the fail bit matches the transaction. Conversely, a port which by default prevents access, would allow access only if a rule allows that transaction to pass.

Exclusive transactions are security checked on the read operation only. A write operation can occur only if a valid read is marked in the internal exclusive table. Consequently, a master performing an exclusive read followed by a write, can write to memory only if the exclusive read was successful.

Example of Configuration for TrustZone

For a TrustZone configuration, memory is divided into a range of memory accessible by secure masters and a range of memory accessible by nonsecure masters. The two memory address ranges may have a range of memory that overlaps.

This example implements the following memory configuration:

- 2 GB total RAM size
- 0—512 MB dedicated secure area
- 513—576 MB shared area
- 577—2048 MB dedicated nonsecure area

In this example, each port is configured by default to disallow all accesses. [Table 8-5](#) shows the two rules programmed into the memory protection table.

Table 8-5. Rules in Memory Protection Table for Example Configuration

Rule #	Port Mask	TID Low	TID High	Address Low	Address High	Prot	Fail/Allow
1	0'b1111111111	0	4095	0	576	b01	allow
2	0'b1111111111	0	4095	512	2047	b00	allow

The port mask value, TID Low, and TID High, apply to all ports and all transfers within those ports. Each access request is evaluated against the memory protection table, and will fail unless a rule matches allowing a transaction to complete successfully.

[Table 8-6](#) shows the result for a sample set of transactions.

Table 8-6. Result for a Sample Set of Transactions

Operation	Source	Address	Prot	Result	Comments
Read	CPU	4096	1	Allow	Matches rule 1.
Write	CPU	536, 870, 912 (512 MB)	1	Allow	Matches rule 1.
Write	L3 attached masters	605, 028, 350 (577 MB)	1	Fail	Does not match rule 1 (out of range of the address field), does not match rule 2 (protection bit incorrect).
Read	L3 attached masters	4096	0	Fail	Does not match rule 1 (prot value wrong), does not match rule 2 (not in address range).
Write	CPU	536, 870, 912 (512 MB)	0	Allow	Matches rule 2.
Write	L3 attached masters	605, 028, 350 (577 MB)	0	Allow	Matches rule 2.

If you did not want any overlap between the memory blocks, you could specify the address ranges in the two rules of [Table 8-5](#) to be mutually exclusive. Depending on your desired TrustZone configuration, you can add rules to the memory protection table to create multiple blocks of protected or unprotected space.

SDRAM Power Management

The SDRAM controller subsystem supports the following power saving features in the SDRAM:

- Partial array self-refresh (PASR)
- Power down
- Deep power down for LPDDR2

Power-saving mode initiates either due to a user command or from inactivity.

Power-down mode is initiated by writing to the appropriate control register. It forces the SDRAM burst-scheduling bank-management logic to close all banks and issue the power down command. You can program the controller to enable power-down when the SDRAM burst-scheduling queue is empty for a specified number of clock cycles. The SDRAM automatically reactivates when an active SDRAM command is received.

Other power-down modes are performed only under user control.

DDR PHY

The DDR PHY connects the memory controller and external memory devices in the speed critical command path.

The DDR PHY implements the following functions:

- Calibration—the DDR PHY supports the JEDEC-specified steps to synchronize the memory timing between the controller and the SDRAM chips. The calibration algorithm is implemented in software.
- Memory device initialization—the DDR PHY performs the mode register write operations to initialize the devices. The DDR PHY handles re-initialization after a deep power down.
- Single-data-rate to double-data-rate conversion.

Clocks

All clocks are assumed to be asynchronous with respect to the `ddr_dqs_clk` memory clock. All transactions are synchronized to memory clock domain.

Table 8-7 shows the SDRAM controller subsystem clock domains.

Table 8-7. SDRAM Controller Subsystem Clock Domains

Clock Name	Description
<code>ddr_dq_clk</code>	Clock for PHY
<code>ddr_dqs_clk</code>	Clock for MPFE, single-port controller, CSR access, and PHY
<code>ddr_2x_dqs_clk</code>	Clock for PHY
<code>l4_sp_clk</code>	Clock for CSR interface
<code>mpu_l2_ram_clk</code>	Clock for MPU interface
<code>l3_main_clk</code>	Clock for L3 interface
<code>f2h_sdram_clk[5:0]</code>	Six separate clocks used for the FPGA-to-HPS SDRAM ports to the FPGA fabric

In terms of clock relationships, the FPGA fabric connects the appropriate clocks to write data, read data, and command ports for the constructed ports.



For more information, refer to the *Clock Manager* chapter in volume 3 of the *Cyclone V Device Handbook*.

Resets

The SDRAM controller subsystem supports a full reset (cold reset) and a warm reset, which may or may not preserve the contents of memory. In order to preserve the memory contents, the reset manager can request that the single-port controller place the SDRAM in self-refresh mode prior to issuing the warm reset. If memory contents are preserved, the PHY and the memory timing logic is not reset, but the rest of the controller is reset.



For more information, refer to the *Reset Manager* chapter in volume 3 of the *Cyclone V Device Handbook*.

Initialization

The SDRAM controller subsystem has CSRs which control the operation of the controller including DRAM type, DRAM timing parameters and relative port priorities. It also has a small set of bits which depend on the FPGA fabric to configure ports between the memory controller and the FPGA fabric; these bits are set for you when you configure your implementation using the HPS GUI in Qsys.

The CSRs are configured using a dedicated slave interface, which provides accesses to registers. This region controls all SDRAM operation, MPFE scheduler configuration, and PHY calibration.

The FPGA fabric interface configuration is programmed into the FPGA fabric and the values of these register bits can be read by software. The ports can be configured without software developers needing to know how the FPGA-to-HPS SDRAM interface has been configured.

Protocol Details

Avalon-MM Bidirectional Port

The Avalon-MM bidirectional ports are standard Avalon-MM ports used to dispatch read and write operations. Each configured Avalon-MM bidirectional port consists of the signals listed in [Table 8-8](#).

Table 8-8. Avalon-MM Bidirectional Port Signals (Part 1 of 2)

Name	Bits	Direction	Function
clk	1	In	Clock for the Avalon-MM interface
read	1	In	Indicates read transaction
write	1	In	Indicates write transaction
address	32	In	Address of the transaction
readdata	32, 64, 128, or 256	Out	Read data return
readdatavalid	1	Out	Valid cycle flag for read data return
writedata	32, 64, 128, or 256	In	Write data for a transaction
byteenable	4 (32-bit data), 8(64-bit data), 16(128-bit data), 32(256-bit data)	In	Byte enables for each write byte

Table 8-8. Avalon-MM Bidirectional Port Signals (Part 2 of 2)

Name	Bits	Direction	Function
waitrequest	1	Out	Indicates need for additional cycles to complete a transaction
burstcount	11	In	Transaction burst length

The read and write interfaces are configured to the same size. The byte-enable size scales with the data bus size.



For information about the Avalon-MM protocol, refer to the [Avalon Interface Specifications](#).

Avalon-MM Write Port

The Avalon-MM write ports are standard Avalon-MM ports used only to dispatch write operations. Each configured Avalon-MM write port consists of the signals listed in [Table 8-9](#).

Table 8-9. Avalon-MM Write Port Signals

Name	Bits	Direction	Function
reset	1	In	Reset
clk	1	In	Clock
write	1	In	Indicates write transaction
address	32	In	Address of the transaction
writedata	32, 64, 128, or 256	In	Write data for a transaction
byteenable	4 (32-bit data), 8(64-bit data), 16(128-bit data), 32(256-bit data)	In	Byte enables for each write byte
waitrequest	1	Out	Indicates need for additional cycles to complete a transaction
burstcount	11	In	Transaction burst length



For information about the Avalon-MM protocol, refer to the [Avalon Interface Specifications](#).

Avalon-MM Read Port

The Avalon-MM read ports are standard Avalon-MM ports used only to dispatch read operations. Each configured Avalon-MM read port consists of the signals listed in [Table 8-10](#).

Table 8-10. Avalon-MM Read Port Signals (Part 1 of 2)

Name	Bits	Direction	Function
reset	1	In	Reset
clk	1	In	Clock
read	1	In	Indicates read transaction
address	32	In	Address of the transaction


Table 8-10. Avalon-MM Read Port Signals (Part 2 of 2)


Name	Bits	Direction	Function
readdata	32, 64, 128, or 256	Out	Read data return
readdatavalid	1	Out	Flags valid cycles for read data return
waitrequest	1	Out	Indicates the need for additional cycles to complete a transaction. Needed for read operations when delay is needed to accept the read command.
burstcount	11	In	Transaction burst length

 For information about the Avalon-MM protocol, refer to the *Avalon Interface Specifications*.

AXI Port

The AXI port uses an AXI-3 interface.

 For information about the AXI-3 interface, refer to the *AMBA Open Specifications* on the ARM website (www.arm.com).

 For information about the AXI interface ports in the high-performance II controller (HPC II), refer to the *Functional Description—HPC II Controller* chapter, in the *External Memory Interface Handbook*.

Each configured AXI port consists of the signals listed in **Table 8-11**. Each AXI interface signal is independent of the other interfaces for all signals, including clock and reset.

Table 8-11. AXI Port Signals (Part 1 of 2)

Name	Bits	Direction	Function
ARESETn	1	In	Reset
ACLK	1	In	Clock
Write Address Channel Signals			
AWID	4	In	Write identification tag
AWADDR	32	In	Write address
AWLEN	4	In	Write burst length
AWSIZE	3	In	Width of the transfer size
AWBURST	2	In	Burst type
AWREADY	1	Out	Indicates ready for a write command
AWVALID	1	In	Indicates valid write command.
Write Data Channel Signals			
WID	4	In	Write data transfer ID
WDATA	32, 64, 128 or 256	In	Write data
WSTRB	4, 8, 16, 32	In	Byte-based write data strobe. Each bit width corresponds to 8 bit wide transfer for 32-bit wide to 256-bit wide transfer.

Table 8–11. AXI Port Signals (Part 2 of 2)

Name	Bits	Direction	Function
WLAST	1	In	Last transfer in a burst
WVALID	1	In	Indicates write data+strokes are valid
WREADY	1	Out	Indicates ready for write data and strokes
Write Response Channel Signals			
BID	4	Out	Write response transfer ID
BRESP	2	Out	Write response status
BVALID	1	Out	Write response valid signal
BREADY	1	In	Write response ready signal
Read Address Channel Signals			
ARID	4	In	Read identification tag
ARADDR	32	In	Read address
ARLEN	4	In	Read burst length
ARSIZE	3	In	Width of the transfer size
ARBURST	2	In	Burst type
ARREADY	1	Out	Indicates ready for a read command
ARVALID	1	In	Indicates valid read command
Read Data Channel Signals			
RID	4	Out	Read data transfer ID
RDATA	32, 64, 128 or 256	Out	Read data
RRESP	2	Out	Read response status
RLAST	1	Out	Last transfer in a burs
RVALID	1	Out	Indicates read data is valid
RREADY	1	In	Read data channel ready signal

SDRAM Controller Subsystem Programming Model

Initialization

SDRAM controller configuration occurs through software programming of the configuration registers using the CSR interface. Initialization of the SDRAM controller has two separate regions with different controls.

Timing Parameters

The SDRAM controller supports a complete set of timing parameters, configurable at run time.

SDRAM Controller Address Map and Register Definitions



The address map resides in the [hps.html](#) file that accompanies this handbook volume. Click the link to open the file.

To view the module description and base address, scroll to and click the link for the following module instance:

■ **sdr**

To then view the register and field descriptions, scroll to and click the register names. The register addresses are offsets relative to the base address of each module instance.



The base addresses of all modules are also listed in the *Introduction to the Hard Processor System* chapter in volume 3 of the *Cyclone V Device Handbook*.

Document Revision History

Table 8–12 shows the revision history for this document.

Table 8–12. Document Revision History

Date	Version	Changes
November 2012	1.1	Added address map and register definitions section.
January 2012	1.0	Initial release.

The hard processor system (HPS) contains the following on-chip memory:

- On-Chip RAM
- Boot ROM

The on-chip RAM provides 64 KB of general-purpose RAM. The boot ROM contains the code required to boot the HPS from cold or warm reset. Both memories connect to the level 3 (L3) interconnect.

On-Chip RAM

This section describes the HPS on-chip RAM.

Features of the On-Chip RAM

The on-chip RAM offers the following features:

- 64-bit interface
- 64 KB size
- Single-ported RAM
- Read acceptance of two, write acceptance of two, and a total acceptance of two.
- Error correction code (ECC) support
- Sustained ideal throughput (operating frequency times the data width) during read after read, write after write, write after read, and read after write.

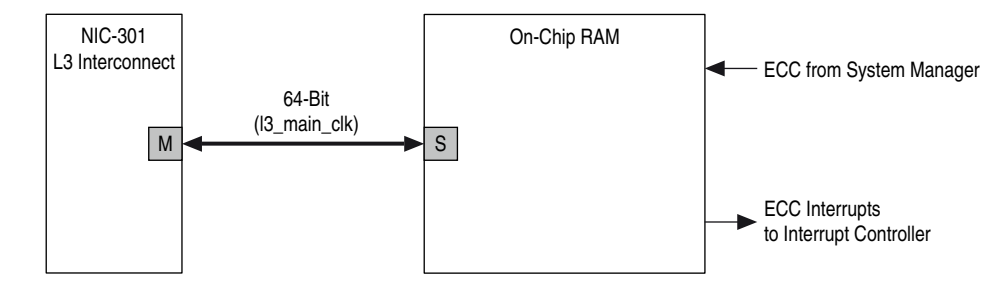


For information about the operating frequency, refer to the *Clock Manager* chapter in volume 3 of the *Cyclone V Device Handbook*.

On-Chip RAM Block Diagram and System Integration

Figure 9-1 shows a block diagram of the on-chip RAM.

Figure 9-1. On-Chip RAM Block Diagram



Transfers between memory and the NIC-301 L3 interconnect happen through a 64-bit interface, gated by the `l3_main_clk` interconnect clock. ECC logic detects single-bit, corrected and double-bit, uncorrected errors. The memory has a read acceptance of two, a write acceptance of two, and a total acceptance of two with round-robin arbitration.

The entire RAM is either secure or nonsecure. Security is enforced by the NIC-301 L3 interconnect.



For more information about security, refer to the *Interconnect* chapter in volume 3 of the *Cyclone V Device Handbook*.

Functional Description of the On-Chip RAM

The on-chip RAM serves as a general-purpose memory accessible from the FPGA.

The on-chip RAM uses an 64-bit slave interface. The slave interface supports transfers between memory and the NIC-301 L3 interconnect. All reads and writes are serviced in order.

Clocks

The on-chip RAM is driven by the `l3_main_clk` interconnect clock.



For information about the operating frequency and maximum throughput, refer to the *Clock Manager* chapter in volume 3 of the *Cyclone V Device Handbook*.

Resets

The contents of the RAM remain unchanged on a cold or warm reset. Reset only clears the state associated with the slave interface.


The on-chip RAM reset is driven by the `onchip_ram_rst_n` interconnect reset signal.



For more information, refer to the *Reset Manager* chapter in volume 3 of the *Cyclone V Device Handbook*.

Boot ROM


This section describes hardware aspects of the HPS boot ROM.

 For information about the boot ROM software, refer to the *Booting and Configuration* appendix in volume 3 of the *Cyclone V Device Handbook*.

Features of the Boot ROM

The boot ROM offers the following features:

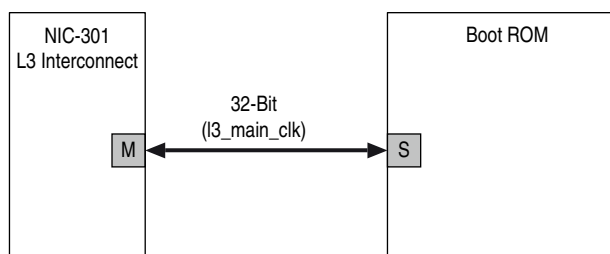
- 32-bit interface
- 64 KB size
- Single-ported ROM
- Read acceptance of two
- Sustained ideal throughput (operating frequency times the data width) during read after read.

 For information about the operating frequency, refer to the *Clock Manager* chapter in volume 3 of the *Cyclone V Device Handbook*.

Boot ROM Block Diagram and System Integration


Figure 9–2 shows a block diagram of the boot ROM.

Figure 9–2. Boot ROM Block Diagram



Transfers between memory and the NIC-301 L3 interconnect happen through a 32-bit interface, gated by the `l3_main_clk` interconnect clock.

The entire RAM is either secure or nonsecure. Security is enforced by the NIC-301 L3 interconnect.

 For more information about security, refer to the *Interconnect* chapter in volume 3 of the *Cyclone V Device Handbook*.

Functional Description of the Boot ROM

The boot ROM is used only for booting the system. On a cold or warm reset of the microprocessor unit (MPU) subsystem, MPU0 executes the pre-bootloader code stored in the boot ROM.

- For information about the boot ROM software, refer to the *Booting and Configuration* appendix in volume 3 of the *Cyclone V Device Handbook*.

The boot ROM uses an 32-bit slave interface. The slave interface supports transfers between memory and the NIC-301 L3 interconnect. All writes return an error response.

Clocks

The boot ROM is driven by the `l3_main_clk` interconnect clock.

- For information about the operating frequency and maximum throughput, refer to the *Clock Manager* chapter in volume 3 of the *Cyclone V Device Handbook*.

Resets

The contents of the ROM remain unchanged on a cold or warm reset. Reset only clears the state associated with the slave interface.

The boot ROM reset is driven by the `boot_rom_rst_n` interconnect clock.

- For more information, refer to the *Reset Manager* chapter in volume 3 of the *Cyclone V Device Handbook*.

On-Chip Memory Address Map and Register Definitions

There are no registers for on-chip memory.

- The address map resides in the [hps.html](#) file that accompanies this handbook volume. Click the link to open the file.

To view the module descriptions and base addresses, scroll to and click the links for the following module instances:

- `rom`
- `ocram`

- The base addresses of all modules are also listed in the *Introduction to the Hard Processor System* chapter in volume 3 of the *Cyclone V Device Handbook*.

Document Revision History

Table 9-1 shows the revision history for this document.

Table 9-1. Document Revision History

Date	Version	Changes
November 2012	1.1	Added address map section.
January 2012	1.0	Initial release.

The hard processor system (HPS) provides a NAND flash controller to interface with external NAND flash memory in Altera® system-on-a-chip (SoC) FPGA systems. You can use external flash memory to store a processor boot image, software, or as extra storage capacity for large applications or user data. The HPS NAND flash controller is based on the Cadence® Design IP® NAND Flash Memory Controller.

NAND Flash Controller Features

The NAND flash controller provides the following functionality and features:

- Supports one x8 NAND flash device
- Supports Open NAND Flash Interface (ONFI) 1.0
- Supports NAND flash memories from Hynix, Samsung, Toshiba, Micron, and ST Micro
- Supports programmable 512 byte (4-, 8-, or 16-bit correction) or 1024 byte (24-bit correction) error correction code (ECC) sector size
- Supports pipeline read-ahead and write commands for enhanced read/write throughput
- Supports devices with 32, 64, 128, 256, 384, or 512 pages per block
- Supports multiplane devices
- Supports page sizes of 512 bytes, 2 kilobytes (KB), 4 KB, or 8 KB
- Supports single-level cell (SLC) and multi-level cell (MLC) devices with programmable correction capabilities
- Provides internal direct memory access (DMA)
- Provides programmable access timing

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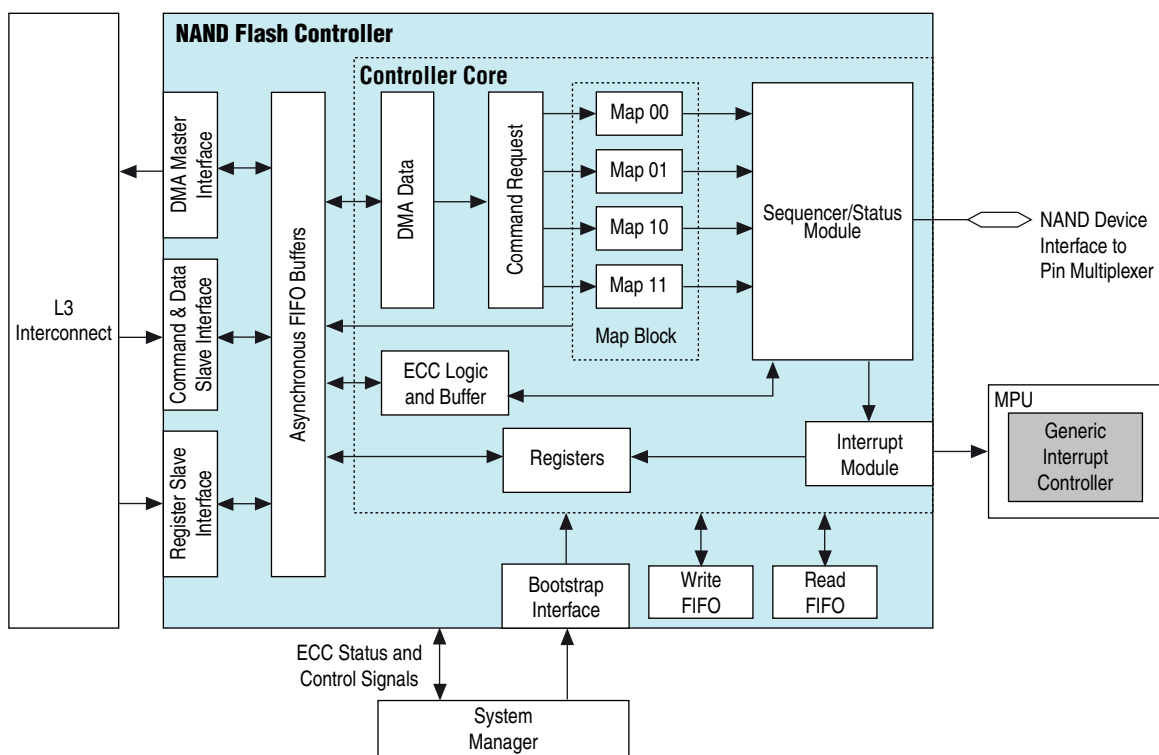
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NAND Flash Controller Block Diagram and System Integration

Figure 10-1 shows integration of the NAND flash controller in the HPS. The flash controller receives commands and data from the host through the command and data slave interface. The host accesses the flash controller's control and status registers (CSRs) through the register slave interface. The flash controller handles all command sequencing and flash device interactions. The bootstrap interface supports configuration of the NAND flash controller when booting the HPS from NAND flash memory. The flash controller generates interrupts to the HPS Cortex™-A9 MPCore™ processor generic interrupt controller. The DMA master interface provides accesses to and from the flash controller through the controller's built-in DMA.

Figure 10-1. NAND Flash Controller Block Diagram



Functional Description of the NAND Flash Controller

This section describes the functionality of the NAND flash controller.

Discovery and Initialization

The NAND flash controller requires a specific initialization sequence after the HPS receives power and the flash device is stable. During initialization, the flash controller queries the flash device and configures itself according to one of the following flash device types:

- ONFI 1.0 compliant devices
- Legacy (non-ONFI) NAND devices

The NAND flash controller identifies ONFI-compliant connected devices using ONFI discovery protocol, by sending the Read Electronic Signature command. For devices that do not recognize this command (especially for 512-byte page size devices), software must write to the system manager to assert the `bootstrap_512B_device` signal to identify the device type before reset is de-asserted.

To support booting and initialization, the `rdy_busy_in` pin must be connected. The NAND flash controller sends the `reset` command to the connected device.

The NAND flash controller performs the following initialization steps:

1. If the system manager is asserting `bootstrap_inhibit_init`, the flash controller goes directly to step 7.
2. When the device is ready, the flash controller sends the ONFI Read ID command to read the ONFI signature from the device, to determine whether an ONFI or a legacy device is connected.
3. If the data returned by the device has an ONFI signature, the flash controller then reads the device parameter page. The flash controller stores the relevant device feature information in internal memory control registers, enabling it to correctly program other registers in the flash device, and goes to step 5.
4. If the data does not have a valid ONFI signature, the flash controller assumes that it is a legacy (non-ONFI) device. The flash controller then performs the following steps:
 - a. Sends the `reset` command to the device
 - b. Reads the device signature information
 - c. Stores the relevant values into internal memory controller registers
5. The flash controller resets the device. At the same time, it verifies the width of the memory interface. The HPS supports one 8-bit NAND flash device. As a result, the flash controller always detects an 8-bit memory interface.
6. The flash controller sends the Page Load command to block 0, page 0 of the device, configuring direct read access, so the processor can boot from that page. The processor can start reading from the first page of the device, which is the expected location of the preloader software.



The system manager can bypass this step by asserting `bootstrap_inhibit_b0p0_load` before reset is deasserted.

7. The flash controller sends the `reset` command to the device.
8. The flash controller sets the value of the `rst_comp` bit in the `intr_status0` register in the status group.

Bootstrap Interface

The NAND flash controller provides a bootstrap interface that allows software to override the default behavior of the flash controller. The bootstrap interface contains four bits, which when set appropriately allow the flash controller to skip the initialization phase and begin loading from flash memory immediately after reset. These bits are driven by software through the system manager. They are sampled by the NAND flash controller when the controller is released from reset.


 For more information about the bootstrap interface control bits, refer to the *System Manager* chapter in volume 3 of the *Cyclone V Device Handbook*.

Table 10-1 lists the relevant bootstrap setting bits, found in the system manager's bootstrap register, in the `nandgrp` group. This table also lists recommended bootstrap settings for a 512 byte page device.

Table 10-1. Recommended Bootstrap Settings for 512 Byte Page Device

Register	Value
<code>noinit</code>	1 ⁽¹⁾
<code>page512</code>	1
<code>noloadb0p0</code>	1
<code>tworowaddr</code>	<ul style="list-style-type: none"> ■ 1—flash device supports two-cycle addressing ■ 0—flash device support three-cycle addressing
Note to Table 10-1: (1) When this register is set, the NAND flash controller expects the host to program the related device parameter registers. For more information, refer to "Configuration by Host".	

Configuration by Host

If the system manager sets `bootstrap_inhibit_init` to 1, the NAND flash controller does not perform the discovery and initialization process. In this case, the host processor must configure the flash controller.

When performance is not a concern in the design, the timing registers can be left unprogrammed.

Table 10-2 shows the recommended configuration by host settings to enable the basic read, write, and erase operations for a single-plane, 512 bytes/page device.

Table 10-2. Recommended Bootstrap Settings for 512 Byte Page Device

Register ⁽¹⁾	Value
<code>devices_connected</code>	1
<code>device_width</code>	0 indicating an 8-bit NAND flash device
<code>number_of_planes</code>	1 indicating a single-plane device
<code>device_main_area_size</code>	The value of this register must reflect the flash device's page main area size.
<code>device_spare_area_size</code>	The value of this register must reflect the flash device's page spare area size.
<code>pages_per_block</code>	The value of this register must reflect number of pages per block in the flash device.

Note to Table 10-2:

(1) All registers are in the `config` group.

Each NAND page has a main area and a spare area. The main area is intended for data storage. The spare area is intended for ECC and maintenance data, such as wear leveling information. Each block consists of a group of pages.

The sizes of the main and spare areas, and the number of blocks in a page, depend on the specific NAND device connected to the NAND flash controller. Therefore, the device-dependent registers, `device_main_area_size`, `device_spare_area_size`, and `pages_per_block`, must be programmed to match the characteristics of the device.

If your software does not perform the discovery and initialization sequence, the software must include an alternative method to determine the correct value of the device-dependent registers. The HPS boot ROM code enables discovery and initialization by default (that is, `bootstrap_inhibit_init = 0`).

Clocks

Table 10–3 lists the NAND flash controller clock inputs.

Table 10–3. Clock Inputs to NAND Flash Controller

Clock Signal	Description
<code>nand_x_clk</code>	Clock for master and slave interfaces and the ECC sector buffer
<code>nand_clk</code>	Clock for the NAND flash controller

The frequency of `nand_x_clk` is four times the frequency of `nand_clk`.



For more information about the clock inputs, refer to the *Clock Manager* chapter in volume 3 of the *Cyclone V Device Handbook*.

Resets

The NAND flash controller has one reset signal. The reset manager drives this signal to the NAND flash controller on a cold or warm reset.

Before the NAND flash controller comes out of the reset state, the pin multiplexers for the flash external interface must be configured.



For more information about the reset manager, refer to the *Reset Manager* chapter in volume 3 of the *Cyclone V Device Handbook*.

Indexed Addressing

The NAND flash controller uses indexed addressing to reduce the address span consumed by the flash controller. Indirect addressing is controlled by two registers, accessed through the command and data slave interface in the `nanddata` map, as described in [Table 10-4](#).

Table 10-4. Register Map for Indexed Addressing

Register Name	Offset Address	Usage
Control	0x0	Software writes the 32-bit control information consisting of MAP command type, block, and page address. The upper four bits must be set to 0. For specific usage of the Control register, refer to Table 10-5 through Table 10-8 .
Data	0x10	The Data register is a page-size window into the NAND flash. By reading from or writing to locations starting at this offset, the software reads directly from or writes directly to the page and block of NAND flash memory specified by the Control register.

The host uses indexed addressing as follows:

1. Program the 32-bit index-address field into the Control register at offset 0x0 of the data/command slave port. This action provides the flash address parameters to the NAND flash controller.
2. Perform 32-bit read or write in the Data register at offset 0x10 of the data/command slave port.
3. Perform additional 32-bit reads and writes if they are in the same page and block in flash memory.

It is unnecessary to write to the control register for every data transfer if a group of data transfers targets the same page and block address. For example, you can write the control register at the beginning of a page with the block and page address, and then read or write the entire page by directing consecutive transactions to the Data register.

Command Mapping

The NAND flash controller supports several flash controller-specific MAP commands, providing an abstraction level for programming a NAND flash device. By using the MAP commands, you can avoid directly programming device-specific commands. Using this abstraction layer provides enhanced performance. Commands take multiple cycles to send off-chip. The MAP commands let you initiate commands and let the flash controller sequence them off-chip to the NAND device.

The NAND flash controller supports the following flash controller-specific MAP commands:

- **MAP00 Commands**—boot-read or buffer read/write during read-modify-write operations
- **MAP01 Commands**—memory arrays read/write

- **MAP10 Commands**—NAND flash controller commands
- **MAP11 Commands**—low-level direct access

MAP00 Commands

MAP00 commands access a page buffer in the NAND flash device. Addressing always begins at 0x0 and extends to the page size specified by the `device_main_area_size` and `device_spare_area_size` registers in the `config` group. You can use this command to perform a boot read. Use MAP00 commands in read-modify-write (RMW) operations to read or write any word in the buffer. MAP00 commands allow a direct data path to the page buffer in the device.

The host can access the page buffer directly using the MAP00 commands only if there are no other MAP01 or MAP10 commands active on the NAND flash controller.

Table 10-5 lists the address bits as interpreted by the NAND flash controller for a MAP00 command.

Table 10-5. MAP00 Address Mapping

Address Bits	Name	Description
31:28	(reserved)	Set to 0
27:26	CMD_MAP	Set to 0
25:13	(reserved)	Set to 0
12:2	BUFF_ADDR	Data width-aligned buffer address on the memory device. Maximum page access is 8 KB.
1:0	(reserved)	Set to 0

The usage of this command under normal operations is limited to the following situations:

- It can be used to perform an Execute-in-Place (XIP) boot from the device; reading directly from the page buffer while booting directly from the device.
- MAP00 commands can be used to perform RMW operations where MAP00 writes are used to modify a read page in the device page buffer. Because the NAND flash controller does not perform ECC correction during such an operation, this method is not recommended in an MLC device.
- In association with MAP11 commands, MAP00 commands provide a way for the host to directly access the device bypassing the hardware abstractions provided by NAND flash controller with MAP01 and MAP10 commands. This method is also used for debugging, or for issuing an operation that the flash controller might not support with MAP01 or MAP10 commands.

Restrictions:

- MAP00 commands cannot be used with MAP01 commands to read part of a page. Accesses using MAP01 commands must perform a complete page transfer.
- No ECC is performed during a MAP00 data access.
- DMA must be disabled (the `flag` bit of the `dma_enable` register in the `dma` group must be set to 0) while performing MAP00 operations.

MAP01 Commands

MAP01 commands transfer complete pages between the host memory and a specific page of the NAND flash device. Because the NAND flash controller supports only page addresses, the entire page must be read or written at once. The actual number of commands required depends on the size of the data transfer. You must use the same address until the entire page is transferred, even if multiple commands are required.

When the NAND flash controller receives a read command, it issues a load operation on the device, waits for the load to complete, and then returns read data. Read data must be read from the start of the page to the end of the page. Write data must be written from the start of the page to the end of the page.

When the NAND flash controller receives confirmation of the transfer, it issues commands to program the data into the device. The flash controller ignores the byte enables for read and write commands and transfers the entire data width.

Table 10-6 lists the address bits as interpreted by the NAND flash controller for a MAP01 command.

Table 10-6. MAP01 Address Mapping

Address Bits	Name	Description
31:28	(reserved)	Set to 0
27:26	CMD_MAP	Set to 1
25:24	(reserved)	Set to 0
23:<M> (1)	BLK_ADDR	Block address in the device
(<M>-1):0 (1)	PAGE_ADDR	Page address in the device

Note to Table 10-6:

- (1) <M> depends on the number of pages per block in the device. $\langle M \rangle = \text{ceil}(\log_2(\text{device pages per block}))$. Therefore, use the following values:
- 32 pages per block: $\langle M \rangle = 5$
 - 64 pages per block: $\langle M \rangle = 6$
 - 128 pages per block: $\langle M \rangle = 7$
 - 256 pages per block: $\langle M \rangle = 8$
 - 384 pages per block: $\langle M \rangle = 9$
 - 512 pages per block: $\langle M \rangle = 9$

The NAND flash controller incorporates ECC on-the-fly correction that corrects data read from the device internally before transferring the data out from the flash controller. The ECC sector buffers store data, while the ECC engine computes the error location.

Use the MAP01 command as follows:

- A complete page must be read or written using a MAP01 command. During such transfers, every transaction from the host must have the same block and page address. The NAND flash controller internally keeps track of how much of data it reads or writes.
- MAP00 commands cannot be used in between using MAP01 commands for reading or writing a page.
- DMA must be disabled (the `flag` bit of the `dma_enable` register in the `dma` group must be set to 0) while the host is performing MAP01 operations directly. If the host issues MAP01 commands to the NAND flash controller while DMA is enabled, the flash controller discards the request and generates an `unsup_cmd` interrupt.

MAP10 Commands

MAP10 commands provide an interface to the control plane of the NAND flash controller. MAP10 commands control special functions of the flash device, such as erase, lock, unlock, copy back, and page spare area access. Data passed in this command pathway targets the NAND flash controller rather than the flash device. Unlike other command types, the data (input or output) related to these transactions does not affect the contents of the flash device. Rather, this data specifies and performs the exact commands of the flash controller. Only the lower 16 bits of the Data register contain the relevant information.

Table 10-7 lists the address bits as interpreted by the NAND flash controller for a MAP10 command.

Table 10-7. MAP10 Address Mapping

Address Bits	Name	Description
31:28	(reserved)	Set to 0
27:26	CMD_MAP	Set to 2
25:24	(reserved)	Set to 0
23:<M> ⁽¹⁾	BLK_ADDR	Block address in the device
(<M>-1):0 ⁽¹⁾	PAGE_ADDR	Page address in the device

Note to Table 10-7:

- (1) <M> depends on the number of pages per block in the device. $\langle M \rangle = \text{ceil}(\log_2(\text{device pages per block}))$. Therefore, use the following values:
- 32 pages per block: $\langle M \rangle = 5$
 - 64 pages per block: $\langle M \rangle = 6$
 - 128 pages per block: $\langle M \rangle = 7$
 - 256 pages per block: $\langle M \rangle = 8$
 - 384 pages per block: $\langle M \rangle = 9$
 - 512 pages per block: $\langle M \rangle = 9$

Table 10-8 lists the special functions defined by MAP10 command.

Table 10-8. MAP10 Operations

Command	Function
0x01	Sets block address for erase and initiates operation
0x10	Sets unlock start address
0x11	Sets unlock end address and initiates unlock
0x21	Initiates a lock of all blocks
0x31	Initiates a lock-tight of all blocks
0x41	Sets up for spare area access
0x42	Sets up for default area access
0x43	Sets up for main+spare area access
0x60	Loads page to the buffer for a RMW operation
0x61	Sets the destination address for the page buffer in RMW operation
0x62	Writes the page buffer for a RMW operation
0x1000	Sets copy source address
0x11<PP>	Sets copy destination address and initiates a copy of <PP> pages
0x20<PP>	Sets up a pipeline read-ahead of <PP> pages
0x21<PP>	Sets up a pipeline write of <PP> pages

Use the MAP10 command as follows:

- MAP10 commands should be used to issue commands to the device, such as erase, copy-back, lock, or unlock.
- MAP10 pipeline commands should also be used to read or write consecutive multiple pages from the flash device within a device block boundary. The host must first issue a MAP10 pipeline read or write command and then issue MAP01 commands to do the actual data transfers. The MAP10 pipeline read or write command instructs the NAND flash controller to use high-performance commands such as cache or multiplane because the flash controller has knowledge of multiple consecutive pages to be read. The pages must not cross a block boundary. If a block boundary is crossed, the flash controller generates an unsupported command (unsup_cmd) interrupt and drops the command.
- Up to four pipeline read or write commands can be issued to the NAND flash controller.
- While the NAND flash controller is performing MAP10 pipeline read or write commands, DMA must be disabled (the flag bit of the dma_enable register in the dma group must be set to 0). DMA must be disabled because the host is directly transferring data from and to the flash device through the flash controller.

MAP11 Commands

MAP11 commands provide direct access to the NAND flash controller's address and control cycles, allowing software to issue the commands directly to the flash device using the Command and Data registers. The MAP11 command is useful if the flash device supports a device-specific command not supported by standard flash commands. It can also be useful for low-level debugging.

MAP11 commands provide a direct control path to the flash device. These commands execute command, address, and data read/write cycles directly on the NAND device interface. Command, address, and write data values are placed in the Data register. On a read, the returned data also appears in the Data register. The indirect address register encodes the control operation type. Command and address cycles to the device must be a write transaction on the host bus. For data cycles, the type of transaction on the host bus (read/write) determines the data cycle type on the device interface. The host can issue only single-beat accesses to the data slave port while using MAP11 commands.

Table 10-9 lists the address bits as interpreted by the NAND flash controller for a MAP11 command.

Table 10-9. MAP11 Addressing Mapping

Address Bits	Name	Description
31:28	(reserved)	Set to 0
27:26	CMD_MAP	Set to 3
25:2	(reserved)	Set to 0
1:0	TYPE	Sets the control type as follows: <ul style="list-style-type: none"> ■ 0 = Command cycle ■ 1 = Address cycle ■ 2 = Data Read/Write Cycle

Use the MAP11 command as follows:

- Use MAP11 commands only in special cases, for debugging or sending device-specific commands that are not supported by the NAND flash controller.
- DMA must be disabled before you use MAP11 operations.
- The host can use only single beat access transfers when using MAP11 commands.



MAP11 commands provide direct, unstructured access to the NAND flash device. Incorrect use can lead to unpredictable behavior.

Data DMA

The DMA transfers data with minimal host involvement. Software initiates data DMA with the MAP10 command.

The flag bit of the dma_enable register in the dma group enables data DMA functionality. Only enable or disable this functionality when there are no active transactions pending in the NAND flash controller. When the DMA is enabled, the flash controller initiates one DMA transfer per MAP10 command over the DMA master interface. When the DMA is disabled, all operations with the flash controller occur through the data/command slave interface.

The NAND flash controller supports up to four outstanding DMA commands, and ignores additional DMA commands. If software issues more than four outstanding DMA commands, the flash controller issues the `unsup_cmd` interrupt. On receipt of a DMA command, the flash controller performs command sequencing to transfer the number of pages requested in the DMA command. The DMA master reads or writes page data from the system memory in programmed burst-length chunks. After the DMA command completes, the flash controller issues an interrupt, and starts working on the next queued DMA command.

Pipelining allows the NAND flash controller to optimize its performance while executing back-to-back commands of the same type.

With certain restrictions, non-DMA MAP10 commands can be issued to the NAND flash controller while the flash controller is servicing DMA transactions. MAP00, MAP01, and MAP11 commands cannot be issued while DMA mode is enabled because the flash controller is operating in an extremely tightly-coupled, high-performance data transfer mode. On receipt of erroneous commands (MAP00, MAP01 or MAP11), the flash controller issues an `unsup_cmd` interrupt to inform the host about the violating command.

When the host issues a data DMA command the NAND flash controller transfers data between the flash device and host memory if data DMA is enabled (the `flag` bit of the `dma_enable` register in the `dma` group is set to 1). On the completion of the transfer the flash controller informs the host by asserting an interrupt.

- A data DMA command is a type of MAP10 command. This command is interpreted by the data DMA engine and not by the flash controller core.
- No MAP01, MAP00, or MAP11 commands are allowed when DMA is enabled.
- Before the flash controller can accept data DMA commands, DMA must be enabled by setting the `flag` bit of the `dma_enable` register in the `dma` group.
- When DMA is enabled and the DMA engine initiates data transfers, ECC can be enabled for as-needed data correction concurrent with the data transfer.
- MAP10 commands are used along with data movements similar to MAP01 commands.
- With the exception of data DMA commands and MAP10 pipeline read and write commands, all other MAP10 commands such as erase, lock, unlock, and copy-back are forwarded to the flash controller.
- At any time, up to four outstanding data DMA commands can be handled by flash controller. During multi-page operations, the DMA transfer must not cross a flash block boundary. If it does, the flash controller generates an unsupported command (`unsup_cmd`) interrupt and drops the command.
- Data DMA commands are typically multi-page read and write commands with an associated pointer in host memory. The multi-page data is transferred to or from the host memory starting from the host memory pointer.
- Data DMA uses the `flash_burst_length` register in the `dma` group to determine the burst length value to drive on the interconnect. The data DMA hardware does not account for the interconnect's boundary crossing restrictions. The host must initialize the starting host address so that the DMA master burst does not cross a 4 KB boundary.

There are two methods for initiating a DMA transaction: the multitransaction DMA command, and the burst DMA command.

Multitransaction DMA Command

To initiate DMA with a multitransaction DMA command, you send four command-data pairs to the NAND flash controller's data and control slave port, as shown in Table 10-10 through Table 10-13.

The NAND flash controller processes multitransaction DMA commands only if it receives all four command-data pairs in order. The flash controller responds to out-of-order commands with an `unsup_cmd` interrupt. The flash controller also responds with an `unsup_cmd` interrupt if sequenced commands are interleaved with other flash controller MAP commands.

Table 10-10 through Table 10-13 show the format of each command-data pair.

Table 10-10. Command-Data Pair 1

	31:28	27:26	25:24	23:<M> ⁽¹⁾	(<M> - 1):0 ⁽¹⁾
Command	0x0	0x2	0x0	Block address	Page address

	31:16	15:12	11:8	7:0
Data	0x0	0x2	0x0 = Read 0x1 = Write	<PP>= Number of pages

Note to Table 10-10:

(1) <M> depends on the number of pages per block in the device. <M> = ceil (log2 (<device pages per block>)). Therefore, use the following values:

32 pages per block: <M>=5
64 pages per block: <M>=6
128 pages per block: <M>=7
256 pages per block: <M>=8
384 pages per block: <M>=9
512 pages per block: <M>=9

Table 10-11. Command-Data Pair 2

	31:28	27:26	25:24	23:8	7:0
Command	0x0	0x2	0x0	memory address high ⁽¹⁾	0x0

	31:16	15:12	11:8	7:0
Data	0x0	0x2	0x2	0x0

Note to Table 10-11:

(1) The buffer address in host memory, which must be aligned to 32 bits

Table 10-12. Command-Data Pair 3

	31:28	27:26	25:24	23:8	7:0
Command	0x0	0x2	0x0	memory address low ⁽¹⁾	0x0

	31:16	15:12	11:8	7:0
Data	0x0	0x2	0x3	0x0

Note to Table 10-12:

(1) The buffer address in host memory, which must be aligned to 32 bits

Table 10-13. Command-Data Pair 4

	31:28	27:26	25:24	23:17	16	15:8	7:0
Command	0x0	0x2	0x0	0x0	INT ⁽¹⁾	Burst length	0x0

	31:16	15:12	11:8	7:0
Data	0x0	0x2	0x4	0x0

Note to Table 10-13:

(1) INT specifies the host interrupt to be generated at the end of the complete DMA transfer. INT controls the value of the `dma_cmd_comp` bit of the `intr_status0` register in the `status` group at the end of the DMA transfer. INT can take on one of the following values:

0—Do not interrupt host. The `dma_cmd_comp` bit is set to 0.

1—Interrupt host. The `dma_cmd_comp` bit is set to 1.

For more information, refer to “[Indexed Addressing](#)” on page 10-6.

If you want the NAND flash controller DMA to perform cacheable accesses then you must configure the cache bits by writing the `13master` register in the `nandgrp` group in the system manager. The NAND flash controller DMA must be idle before you use the system manager to change its cache capabilities.



For more information about the system manager, refer to the [System Manager](#) chapter in volume 3 of the *Cyclone V Device Handbook*.

You can issue non-DMA MAP10 commands while the NAND flash controller is in DMA mode. For example, you might trigger a host-initiated page move between DMA commands, to achieve wear leveling. However, do not interleave non-DMA MAP10 commands between the command-data pairs in a set of multitransaction DMA commands. You must issue all four command-data pairs shown in [Table 10-10](#) through [Table 10-13](#) before sending a different command.

Do not issue MAP00, MAP01 or MAP11 commands while DMA is enabled.

MAP10 commands in multitransaction format are written to the Data register at offset 0x10 in `nanddata`, the same as MAP10 commands in increment four (INCR4) format (described in “[Burst DMA Command](#)”).

Burst DMA Command

You can initiate a DMA transfer by sending a command to the NAND flash controller as a burst transaction of four 16-bit accesses. This form of DMA command might be useful for initiating DMA transfers from custom IP in the FPGA fabric. Most processor cores cannot use this form of DMA command, because they cannot control the width of the burst.

When DMA is enabled, the NAND flash controller recognizes the MAP10 pipeline DMA command, in the format shown in Table 10-14, as an INCR4 command. The address decoding for MAP10 pipeline DMA command remains the same, as shown in Table 10-7 on page 10-9. Table 10-14 lists the MAP10 burst DMA command structure. The burst DMA command carries the same information as the multitransaction DMA command-data pairs, but in a very different format.

MAP10 commands in INCR4 format are written to the Data register at offset 0x10 in `nanddata`, the same as MAP10 commands in multitransaction format (described in “Multitransaction DMA Command”).

Table 10-14. MAP10 Burst DMA (INCR4) Command Structure

Data Beat	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
Beat 0	0x2				0x0: read, 0x1: write				<PP>= number of pages							
Beat 1 (1)	memory address high															
Beat 2 (1)	memory address low															
Beat 3	0x0							INT (2)	Burst length							

Notes to Table 10-14:

- (1) The buffer address in host memory, which must be aligned to 32 bits
- (2) INT specifies the host interrupt to be generated at the end of the complete DMA transfer. INT controls the value of the `dma_cmd_comp` bit of the `intr_status0` register in the `status` group at the end of the DMA transfer. INT can take on one of the following values:
0—Do not interrupt host. The `dma_cmd_comp` bit is set to 0.
1—Interrupt host. The `dma_cmd_comp` bit is set to 1.

You can optionally send the 16-bit fields in Table 10-14 to the NAND flash controller as four separate bursts of length 1 in sequential order. Altera recommends this method.

If you want the NAND flash controller DMA to perform cacheable accesses then you must configure the cache bits by writing the `l3master` register in the `nandgrp` group in the system manager. The NAND flash controller DMA must be idle before you use the system manager to modify its cache capabilities.



For more information about the system manager, refer to the *System Manager* chapter in volume 3 of the *Cyclone V Device Handbook*.

ECC

The NAND flash controller incorporates ECC logic to calculate and correct bit errors. The flash controller uses a Bose-Chaudhuri-Hocquenghem (BCH) algorithm for detection of multiple errors in a page.

The NAND flash controller supports 512- and 1024-byte ECC sectors. The flash controller inserts ECC check bits for every 512 or 1024 bytes of data, depending on the selected sector size. After 512 or 1024 bytes, the flash controller writes the ECC check bit information to the device page.

ECC information is striped in between 512 or 1024 bytes of data across the page. The NAND flash controller reads ECC information in the same pattern and the presence of errors is calculated according to 512 or 1024 bytes of data read.

Table 10-15 lists the relationship between different correction capabilities, sector sizes, and the required check-bit sizes written into the spare area.

Table 10-15. Correction Capability, Sector Size, and Check-bit Size

Correction	Sector Size in Bytes	Check-bit Size in Bytes
4	512	8
8	512	14
16	512	26
24	1024	46

The NAND flash controller provides the following ECC programming modes that software uses to format a page:

- Main Area Transfer Mode
- Spare Area Transfer Mode
- Main+Spare Area Transfer Mode

Main Area Transfer Mode

In main area transfer mode, when ECC is enabled, the NAND flash controller inserts ECC check bits in the data stream on writes and strips ECC check bits on reads. Software does not need to manage the ECC sectors when writing a page. ECC checking is performed by the flash controller, so software simply transfers the data.

If ECC is turned off, the NAND flash controller does not read or write ECC check bits. Figure 10-2 shows the main area transfer mode programming model.

Figure 10-2. Main Area Transfer Mode Programming Model for ECC

Sector 0	Sector 1	Sector 2	Sector 3
----------	----------	----------	----------

Spare Area Transfer Mode

The NAND flash controller does not introduce or interpret ECC check bits in spare area transfer mode, and acts as pass through for data transfer. Figure 10-3 shows the spare area transfer mode programming model.

Figure 10-3. Spare Area Transfer Mode Programming Model for ECC

Sector 3	ECC3	Flags
----------	------	-------

Main+Spare Area Transfer Mode

In main+spare area transfer mode, the NAND flash controller expects software to format a page as shown in Figure 10-4. When ECC is enabled during a write operation, the flash controller-generated ECC check bits replace the ECC check bit data provided by software. During read operations, the flash controller forwards the ECC check bits from the device to the host. If ECC is disabled, page data received from the software is written to the device, and read data received from the device is forwarded to the host.

Figure 10-4. Main+Spare Area Transfer Mode Programming Model for ECC

Sector 0	ECC0	Sector 1	ECC1	Sector 2	ECC2	Sector 3	ECC3	Flags
----------	------	----------	------	----------	------	----------	------	-------

Preserving Bad Block Markers

When flash device manufacturers test their devices at the time of manufacture, they mark any bad device blocks that are found. Each bad block is marked at specific, known offsets, typically at the base of the spare area. A bad block marker is any byte value other than 0xFF (the normal state of erased flash).

Bad block markers can be overwritten by the last sector data in a page when ECC is enabled. This happens because the NAND flash controller also uses the main area of a page to store ECC information, which causes the last sector to spill over into the spare area. It is necessary for the system to preserve the bad block information prior to writing data, to ensure the correct identification of bad blocks in the flash device.

You can configure the NAND flash controller to skip over a specified number of bytes when it writes the last sector in a page to the spare area. This option allows the flash controller to preserve bad block markers. To use this option, write the desired offset to the `spare_area_skip_bytes` register in the `config` group. For example, if the device page size is 2 KB, and the device manufacturer stores the bad block markers in the first two bytes in the spare area, set the `spare_area_skip_bytes` register to 2. When the flash controller writes the last sector of the page that overlaps with the spare area, it starts at offset 2 in the spare area, skipping the bad block marker at offset 0. A value of 0 (default) specifies that no bytes are skipped. The value of `spare_area_skip_bytes` must be an even number. For example, if the bad block marker is a single byte, set `spare_area_skip_bytes` to 2.

In main area transfer mode, the NAND flash controller does not skip the bad block marker. Instead, it overrides the bad block marker with the value programmed in the `spare_area_marker` register in the `config` group. This 8-bit register is used in conjunction with the `spare_area_skip_bytes` register in the `config` group to determine which bytes in the spare area of a page should be written with a the new marker value. For example, to mark a block as good set the `spare_area_marker` register to 0xFF and set the `spare_area_skip_bytes` register to the number of bytes that the marker should be written to, starting from the base of the spare area.

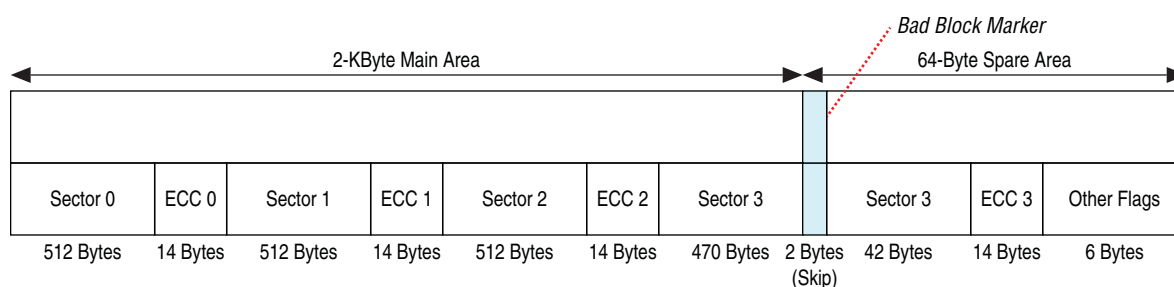
In the spare area transfer mode, the NAND flash controller ignores the `spare_area_skip_bytes` and `spare_area_marker` registers. The flash controller transfers the data exactly as received from the host or device.

In the main+spare area transfer mode, the NAND flash controller starts writing the last sector in a page into the spare area, starting at the offset specified in the `spare_area_skip_bytes` register. However, the area containing the bad block identifier information is overwritten by the data the host writes into the page. The host writes both the data sectors and the bad block markers. The flash controller depends on the host software to set up the bad block markers properly before writing the data.

For more information about the formatting of this data, refer to [Figure 10-4 on page 10-17](#).

[Figure 10-5](#) shows an example of how the NAND flash controller can skip over a bad block marker. In this example, the flash device has a 2-KB page with a 64-byte spare area. A 14-byte sector ECC is shown, with 8 byte per sector correction.

Figure 10-5. Bad Block Marker



For detailed information about configuring the NAND flash controller for default, spare, or main+spare area transfer mode, refer to [“Transfer Mode Operations” on page 10-25](#).

Error Correction Status

The ECC error correction information (`ECCCorInfo_b01`) register, in the `ecc` group, contains error correction information for each read or write that the NAND flash controller performs. The `ECCCorInfo_b01` register contains ECC error correction information in the `max_errors_b0` and `uncor_err_b0` fields.

At the end of data correction for the transaction in progress, `ECCCorInfo_b01` holds the maximum number of corrections applied to any ECC sector in the transaction. In addition, this register indicates whether the transaction as a whole has correctable errors, uncorrectable errors, or no errors at all. A transaction has no errors when none of the ECC sectors in the transaction has any errors. The transaction is marked as uncorrectable if any one of the sectors is uncorrectable. The transaction is marked as correctable if any one sector has correctable errors and none is uncorrectable.

At the end of each transaction, the host must read this register. The value of this register provides data to the host about the block. The host can take corrective action after the number of correctable errors encountered reaches a particular threshold value.

Interface Signals

Table 10-16 lists I/O pin use for the NAND flash interface signals.

Table 10-16. NAND Flash Interface Signals

Signal	Width	I/O	Description
ad	8	in/out	Command, address and data for the flash device
ale	1	out	Address latch enable
ce_n	1	out	Output Active-low chip enable
cle	1	out	Command latch enable
re_n	1	out	Active-low read enable signal
rb	1	in	Ready/busy signal
we_n	1	out	Active-low write enable signal
wp_n	1	out	Active-low write protect signal

The HPS I/O pins support a single x8 device.

NAND Flash Controller Programming Model

This section describes how the NAND flash controller is to be programmed by software running on the microprocessor unit (MPU).



If you write a configuration register and follow it up with a data operation that is dependent on the value of this configuration register, Altera recommends that you read the value of the register before performing the data operation. This read operation ensures that the posted write of the register is completed and takes effect before the data operation is issued to the NAND flash controller.

Basic Flash Programming

This section describes the steps that must be taken by software to access and control NAND flash controller.

NAND Flash Controller Optimization Sequence

The software must configure the flash device for interrupt or polling mode, using the bank0 bit of the rb_pin_enabled register in the config group. If the device is in polling mode, the software must also program the additional registers, to select the times and frequencies of the polling. Program the following registers in the config group:

- Set the rb_pin_enabled register to the desired mode of operation for each flash device.
- For polling mode, set the load_wait_cnt register to the appropriate value depending on the speed of operation of the NAND flash controller, and the desired wait value.
- For polling mode, set the program_wait_cnt register to the appropriate value by software depending on the speed of operation of the NAND flash controller, and the desired wait value.

- For polling mode, set the `erase_wait_cnt` register to the appropriate value by software depending on the speed of operation of the NAND flash controller, and the desired wait value.
- For polling mode, set the `int_mon_cyccnt` register to the appropriate value by software depending on the speed of operation of the NAND flash controller, and the desired wait value.

At any time, the software can change any flash device from interrupt mode to polling mode or vice-versa, using the `bank0` bit of the `rb_pin_enabled` register.

The software needs to ensure that the particular flash device does not have any outstanding transactions before changing the mode of operation for that particular flash device.

Device Initialization Sequence

At initialization, host software must program the following registers in the `config` group:

- Set the `devices_connected` register to 1.
- Set the `device_width` register to 8
- Set the `device_main_area_size` register to the appropriate value.
- Set the `device_spare_area_size` register to the appropriate value.
- Set the `pages_per_block` register according to the parameters of the flash device.
- Set the `number_of_planes` register according to the parameters of the flash device.
- If the device allows two ROW address cycles, the `flag` bit of the `two_row_addr_cycles` register must be set to 1. The host program can ensure this condition either of the following ways:
 - Set the `flag` bit of the `bootstrap_two_row_addr_cycles` register to 1 prior to the NAND flash controller's reset initialization sequence, causing the flash controller to initialize the bit automatically.
 - Set the `flag` bit of the `two_row_addr_cycles` register directly to 1.
- Clear the `chip_enable_dont_care` register in the `config` group to 0.

The NAND flash controller can identify the flash device features, allowing you to initialize the flash controller registers to interface correctly with the device, as described in [“Discovery and Initialization” on page 10-2](#).

However, a few NAND devices do not follow any universally accepted identification protocol. If connected to such a device, the NAND flash controller cannot identify it correctly. If you are using such a device, your software must use other means to ensure that the initialization registers are set up correctly.

Device Operation Control

This section provides a list of registers that you need to program while choosing to use multi-plane or cache operations on the device. If the device does not support multi-plane operations or cache operations, then these registers can be left at their power-on reset values with no impact on the functionality of the NAND flash controller. Even if the device supports these sequences, the software may choose not to use these sequences and can leave these registers at their power-on reset values.

Program the following registers in the `config` group to achieve the best performance from a given device:

- Set flag bit in the `multiplane_operation` register in the `config` group to 1 if the device supports multi-plane operations to access the data on the flash device connected to the NAND flash controller. If the flash controller is set up for multi-plane operations, the number of pages to be accessed is always a multiple of the number of planes in the device.
- If the NAND flash controller is configured for multi-plane operation, and if the device has support for multi-plane read command sequence, then set the `multiplane_read_enable` register in the `config` group.
- If the device implements multiplane address restrictions, set the flag bit in the `multiplane_addr_restrict` register to 1.
- Initialize the `die_mask` and `first_block_of_next_plane` registers as per device requirements.
- If the device supports cache command sequences, enable the `cache_write_enable` and `cache_read_enable` registers in the `config` group.
- Clear the flag bit of the `copyback_disable` register in the `config` group to 0 if the device does not support the copyback command sequences. The register defaults to enabled state.
- The `read_mode`, `write_mode` and `copyback_mode` registers, in the `config` group, currently need not be written by software, because the NAND flash controller is capable of using the correct sequences based on a combination of some multi-plane or cache-related settings of the NAND flash controller and the manufacturer ID. If at some future time these settings change, program the registers to accommodate the change.

ECC Enabling

Before you start any data operation on the flash device, you need to decide whether you want to have the ECC enabled or disabled. If the ECC needs to be enabled, then set up the appropriate correction level depending on the page size and the spare area available on the device.

Set the flag bit in the `ecc_enable` register in the `config` group to 1 to enable ECC. If enabled, the following registers in the `config` group need to be programmed accordingly, else they can be ignored.

- Initialize the `ecc_correction` register to the appropriate correction level.
- Program the `spare_area_skip_bytes` and `spare_area_marker` registers in the `config` group if the software needs to preserve the bad block marker.

For detailed information about ECCs, refer to [“ECC” on page 10-15](#).

NAND Flash Controller Performance Registers

These registers specify the size of the bursts on the device interface, which maximizes the overall performance on the NAND flash controller.

Initialize the `flash_burst_length` register in the `dma` group to a value which maximizes the performance of the device interface by minimizing the number of bursts required to transfer a page.

Interrupt and DMA Enabling

Prior to initiating any data operation on the NAND flash controller, the software must set appropriate interrupt status register bits. If the software chooses to use the DMA logic in the flash controller, then the appropriate DMA enable and interrupts bits in the register space must be set.

- Set the flag bit in the `global_int_enable` register in the `config` group to 1, to enable global interrupt.
- Set the relevant bits of the `intr_en0` register in the `status` group to 1 before sending any operations if the flash controller is in interrupt mode.
- Enable DMA if your application needs DMA mode. Enable DMA by setting the flag bit of the `dma_enable` register in the `dma` group. Altera recommends that the software reads back this register to ensure that the mode change is accepted before sending a DMA command to the flash controller.
- If the DMA is enabled, then set up the appropriate bits of the `dma_intr_en` register in the `dma` group.

Order of Interrupt Status Bits Assertion

The following interrupt status bits, in the `intr_status0` register in the `status` group, are listed in the order of interrupt bit setting:

1. `time_out`—All other interrupt bits are set to 0 when the watchdog `time_out` bit is asserted.
2. `dma_cmd_comp`—This interrupt status bit is the last to be asserted during a DMA operation to transfer data. This bit signifies the completion of data transfer sequence.
3. `pipe_cpybck_cmd_comp`—This bit is asserted when a copyback command or the last page of a pipeline command completes.
4. `locked_blk`—This bit is asserted when a program (or erase) is performed on a locked block.
5. `INT_act`—No relationship with other interrupt status bits. Indicates a transition from 0 to 1 on the `ready_busy` pin value for that flash device.
6. `rst_comp`—No relationship with other interrupt status bits. Occurs after a reset command has completed.
7. For an erase command:
 - a. `erase_fail` (if failure)
 - b. `erase_comp`

8. For a program command:
 - a. `locked_blk` (if performed on a locked block)
 - b. `pipe_cmd_err` (if the pipeline sequence is broken by a MAP01 command)
 - c. `page_xfer_inc` (at the end of each page data transfer)
 - d. `program_fail` (if failure)
 - e. `pipe_cpybck_cmd_comp`
 - f. `program_comp`
 - g. `dma_cmd_comp` (If DMA enabled)
9. For a read command:
 - a. `pipe_cmd_err` (if the pipeline sequence is broken by a MAP01 command)
 - b. `page_xfer_inc` (at the end of each page data transfer)
 - c. `pipe_cpybck_cmd_comp`
 - d. `load_comp`
 - e. `ecc_uncor_error` (if failure)
 - f. `dma_cmd_comp` (If DMA enabled)

Timing Registers

You must optimize the following registers for your flash device's speed grade and clock frequency. The NAND flash controller operates correctly with the power-on reset values. However, functioning with power-on reset values is a non-optimal mode that provides loose timing (large margins to the signals).

Set the following registers in the `config` group to optimize the NAND flash controller for the speed grade of the connected device and frequency of operation of the flash controller:

- `twhr2_and_we_2_re`
- `tcwaw_and_addr_2_data`
- `re_2_we`
- `acc_clks`
- `rdwr_en_lo_cnt`
- `rdwr_en_hi_cnt`
- `max_rd_delay`
- `cs_setup_cnt`
- `re_2_re`

Registers to Ignore

You do not need to initialize the following registers in the config group:

- The `transfer_spare_reg` register. The data transfer mode can be initialized using MAP10 commands.
- The `write_protect` register need not be initialized unless you are testing the write protection feature.

Flash-Related Special Function Operations

This section describes all the special functions that can be performed on the flash memory. The functions are defined by MAP10 commands as described in “[Command Mapping](#)” on page 10-6.

Erase Operations

Before data can be written to flash, an erase cycle must occur. The NAND flash memory controller supports single block and multi-plane erases. The controller decodes the block address from the indirect addressing shown in [Table 10-7](#) on page 10-9.

Single Block Erase

A single command is needed to complete a single-block erase, as follows:

1. Write to the command register, setting the `CMD_MAP` field to 2 and the `BLK_ADDR` field to the desired erase block.
2. Write 0x01 to the Data register.

For a single block erase, the register `multiplane_operation` in the config group must be reset.

After device completes erase operation, the controller generates an `erase_comp` interrupt. If the erase operation fails, the `erase_fail` interrupt is issued. The failing block's address is updated in the `err_block_addr0` register in the status group.

Multi-Plane Erase

For multi-plane erases, the `number_of_planes` register in the config group holds the number of planes in the flash device, and the block address specified must be aligned to the number of planes in the device. The NAND flash controller consecutively erases each block of the memory, up to the number of planes available. Issue this command as follows:

1. Write to the command register, setting the `CMD_MAP` field to 2 and the `BLK_ADDR` field to the desired erase block.
2. Write 0x01 to the Data register.

For multi-plane erase, the register `multiplane_operation` in the config group must be set.

After the device completes erase operation on all planes, the NAND flash controller generates an `erase_comp` interrupt. If the erase operation fails on any of the blocks in a multi-plane erase command, an `erase_fail` interrupt is issued. The failing block's address is updated in the `err_block_addr0` register in the status group.

Lock Operations

The NAND flash controller supports the following features:

- Flash locking—The NAND flash controller supports all flash locking operations.
The flash device itself might have limited support for these functions. If the device does not support locking functions, the flash controller ignores these commands.
- Lock-tight—With the lock-tight feature, the NAND flash controller can prevent lock status from being changed. After the memory is locked tight, the flash controller must be reset before any flash area can be locked or unlocked.

Unlocking a Span of Memory Blocks

To unlock several blocks of memory, perform the following steps:

1. Write to the command register, setting the `CMD_MAP` field to 2 and the `BLK_ADDR` field to the starting address of the area to unlock.
2. Write 0x10 to the Data register.
3. Write to the command register, setting the `CMD_MAP` field to 2 and the `BLK_ADDR` field to the ending address of the area to unlock.
4. Write 0x11 to the Data register.

When unlocking a range of blocks, the start block address must be less than the end block address. Otherwise, the NAND flash controller exhibits undetermined behavior.

Locking All Memory Blocks

To lock the entire memory:

1. Write to the command register, setting the `CMD_MAP` field to 2 and the `BLK_ADDR` field to any memory address.
2. Write 0x21 to the Data register.

Setting Lock-Tight on All Memory Blocks

After the lock-tight is applied, unlocked areas cannot be locked, and locked areas cannot be unlocked.

To lock-tight the entire memory:

1. Write to the command register, setting the `CMD_MAP` field to 2 and the `BLK_ADDR` field to any memory address.
2. Write 0x31 to the Data register.

To disable the lock-tight, reset the memory controller.

Transfer Mode Operations

You can configure the NAND flash controller in one of the following modes of data transfer:

- Default area transfer mode
- Spare area transfer mode
- Main+spare area transfer mode

The NAND flash controller determines the default transfer mode from the setting of `transfer_spare_reg` register in the `config` group. Use MAP10 commands to dynamically change the transfer mode from the existing mode to the new mode. All subsequent commands are in the new mode of transfer. You must consider that transfer modes can be changed at logical data transfer boundaries. For example:

- At the beginning or end of a page in case of single page read or write.
- At the beginning or end of a complete multi-page pipeline read or write command.

Refer to “MAP10 Commands” on page 10-9 for detailed information about the MAP10 commands. Table 10-17 lists the functionality of the MAP10 transfer mode commands, and their mappings to the `transfer_spare_reg` register in the `config` group.

Table 10-17. `transfer_spare_reg` and MAP10 Transfer Mode Commands

<code>transfer_spare_reg</code>	MAP10 Transfer Mode Commands	Resulting NAND Flash Controller Mode
0	0x42	Main ⁽¹⁾
0	0x41	Spare
0	0x43	Main+spare
1	0x42	Main+spare ⁽¹⁾
1	0x41	Spare
1	0x43	Main+spare

Note to Table 10-17:

- (1) Default access mode (0x42) maps to either main (only) or main+spare mode, depending on the value of `transfer_spare_reg`.

Configure for Default Area Access

You only need to configure for default area access if the transfer mode was previously changed to spare area or main+spare area. To configure default area access:

1. Write to the command register, setting the `CMD_MAP` field to 2 and the `BLK_ADDR` field to any block.
2. Write 0x42 to the Data register.

The NAND flash controller determines the default area transfer mode from the setting of the `transfer_spare_reg` register in the `config` group. If it is set to 1, then the transfer mode becomes main+spare area, otherwise it is main area.

Configure for Spare Area Access

To access only the spare area of the flash device, use the MAP10 command to set up the NAND flash controller to read or write only the spare area on the device. After the flash controller is set up, use MAP01 read and write commands to access the spare area of the appropriate block and page addresses. To configure the NAND flash controller to access the spare area only, perform the following steps:

1. Write to the command register, setting the `CMD_MAP` field to 2 and the `BLK_ADDR` field to the target block.
2. Write 0x41 to the Data register.

Configure for Main+Spare Area Access

To configure the NAND flash controller to access the main+spare area:

1. Write to the command register, setting the `CMD_MAP` field to 2 and the `BLK_ADDR` field to the target block.
2. Write 0x43 to the Data register.

Read-Modify-Write Operations

To read a specific page or modify a few words, bytes, or bits in a page, use the RMW operations. A read command copies the desired data from flash memory to a page buffer. You can then modify the information in the buffer using MAP00 buffer read and write commands and issue another command to write that information back to the memory.

The read-modify-write command operates on an entire page. This command is also useful for a copy type operation, where most of a page is saved to a new location. In this type of operation, the NAND flash controller reads the data, modifies a specified number of words in the page, and then writes the modified page to a new location.



Because the data is modified within the page buffer of the flash device, the NAND flash controller ECC hardware is not used in RMW operations. Software must update the ECC during RMW operations.



For a read-modify-write command to work with hardware ECC, the entire page must be read into system memory, modified, then written back to flash without relying on the RMW feature.

Read-Modify-Write Operation Flow

1. The flow starts by reading a page from the memory:
 - Write to the command register, setting the `CMD_MAP` field to 2 and the `BLK_ADDR` field to the starting address of the desired block.
 - Write 0x60 to the Data register.

This step makes the page available to you in the page buffer in the flash device.

2. Next provide destination page address:
 - Write to the command register, setting the `CMD_MAP` field to 2 and the `BLK_ADDR` field to the destination address of the desired block.
 - Write 0x61 to the Data register.

This step initiates the page program and provides the destination address to the device.

3. Use MAP00 page buffer read and write commands to modify the data in the page buffer.

4. Write the page buffer data back to memory:
 - Write to the command register, setting the CMD_MAP field to 2 and the BLK_ADDR field to the same destination address.
 - Write 0x62 to the Data register.

This step performs the write.

After the device completes the load operation, the NAND flash controller issues a `load_comp` interrupt. A `program_comp` interrupt is issued when the host issues the write command and the device completes the program operation.

If the page program operation (as a part of an RMW operation) results in a program failure in the device, `program_fail` interrupt is issued. The failing page's block and page address is updated in the `err_block_addr0` and `err_page_addr0` registers in the `status` group.

Copy-back Operations

The NAND flash controller supports copy back operations. However, the flash device might have limited support for this function. If you attempt to perform a copy-back operation on a device that does not support copy-back, the NAND flash controller triggers an interrupt. An interrupt is also triggered if the source block is not specified before the destination block is specified, or if the destination block is not specified in the next command following a source block specification.

The NAND flash controller cannot do ECC validation in case of copy-back commands. The flash controller copies the ECC data, but does not check it during the copy operation. Altera recommends that you use copy-back only if the ECC implemented in the flash controller is strong enough so that the next access can correct accumulated errors.

The 8-bit value `<PP>` specifies the number of pages for copy-back. With this feature, the NAND flash controller can copy multiple consecutive pages with a single command. When you issue a copy-back command, the flash controller performs the operation in the background. The flash controller puts other commands on hold until the current copy-back completes.

For a multi-plane device, if the `flag` bit in the `multiplane_operation` register in the `config` group is set to 1, multi-plane copy-back is available as an option. In this case, the block address specified must be plane-aligned and the value `<PP>` must specify the total number of pages to copy as a multiple of the number of planes. The block address continues incrementing, keeping the page address fixed, for the total number of planes in the device before incrementing the page address.

A `pipe_cpyback_cmd_comp` interrupt is generated when the flash controller has completed copy-back operation of all `<PP>` pages. If any page program operation (as a part of copy back operation) results in a program failure in the device, the `program_fail` interrupt is issued. The failing page's block and page address is updated in the `err_block_addr0` and `err_page_addr0` registers in the `status` group.

Copying a Memory Area (Single Plane)

To copy *<PP>* pages from one memory location to another:

1. Write to the command register, setting the *CMD_MAP* field to 2 and the *BLK_ADDR* field to the starting address of the area to be copied.
2. Write 0x1000 to the Data register.
3. Write to the command register, setting the *CMD_MAP* field to 2 and the *BLK_ADDR* field to the starting address of the new area to be written.
4. Write 0x11*<PP>* to the Data register, where *<PP>* is the number of pages to copy.

Copying a Memory Area (Multi Plane)

To copy *<PP>* pages from one memory location to another:

1. Set the flag bit of the *multiplane_operation* register in the config group to 1.
2. Write to the command register, setting the *CMD_MAP* field to 2 and the *BLK_ADDR* field to the starting address of the area to be copied. The address must be plane-aligned.
3. Write 0x1000 to the Data register.
4. Write to the command register, setting the *CMD_MAP* field to 2 and the *BLK_ADDR* field to the starting address of the new area to be written. This address must also be plane-aligned.
5. Write 0x11*<PP>* to the Data register, where *<PP>* is the number of pages to copy.

The parameter *<PP>* must be a multiple of the number of planes in the device.

Pipeline Read-Ahead and Write-Ahead Operations

The NAND flash controller supports pipeline read-ahead and write-ahead operations. However, the flash device might have limited support for this function. If the device does not support pipeline read-ahead or write-ahead, the flash controller processes these commands as standard reads or writes.

The NAND flash controller can handle at the most four outstanding pipeline commands, queued up in the order in which the flash controller received the commands. The flash controller operates on the pipeline command at the head of the queue until all the pages corresponding to the pipeline command are executed. The flash controller then pops the pipeline command at the head of the queue and proceeds to work on the next pipeline command in the queue.

The pipeline read-ahead function allows for a continuous reading of the flash memory. On receiving a pipeline read command, the flash controller immediately issues a load command to the device. While data is read out with MAP01 commands in a consecutive or multi-plane address pattern, the flash controller maintains additional cache or multi-plane read command sequencing for continuous streaming of data from the flash device.

The pipeline write-ahead function allows for a continuous writing of the flash memory. While data is written with MAP01 commands in a consecutive or multi-plane address pattern, the NAND flash controller maintains cache or multi-plane command sequences for continuous streaming of data into the flash device.

MAP01 commands must read or write pages in the same sequence that the pipelined commands were issued to the NAND flash controller. If the host issues multiple pipeline commands, pages must be read or written in the order the pipeline commands were issued. It is not possible to read or write pages for a second pipeline command before completing the first pipeline command. If the pipeline sequence is broken by a MAP01 command, the `pipe_cmd_err` interrupt is issued, and the flash controller clears the pipeline command queue. The flash controller services the violating incoming MAP01 read or write request with a normal page read or write sequence.

For a multi-plane device that supports multi-plane programming, you must set the `flag` bit of the `multiplane_operation` register in the `config` group to 1. In this case, the data is interleaved into page-size chunks to consecutive blocks.

Pipeline read-ahead commands can read data from the queue in this interleaved fashion. The parameter `<PP>` denotes the total number of pages in multiples of the number of planes available, and the block address must be plane-aligned, which keeps the page address constant while incrementing the block address for each page-size chunk of data. After reading from every plane, the NAND flash controller increments the page address and resets the block address to the initial address. You can also use pipeline write-ahead commands in multi-plane mode. The write operation works similarly to the read operation, holding the page address constant while incrementing the block address until all planes are written.



The same four-entry queue is used to queue the address and page count for pipeline read-ahead and write-ahead commands. This commonality requires that you use MAP01 commands to read out all pages for a pipeline read-ahead command before the next pipeline command can be processed. Similarly, you must write to all pages pertaining to pipeline write-ahead command before the next pipeline command can be processed.

Since the value of the `flag` bit of the `multiplane_operation` register in the `config` group determines pipeline read-ahead or write-ahead behavior, it can only be changed when the pipeline registers are empty.

When the host issues a pipeline read-ahead command, and the flash controller is idle, the load operation happens immediately.



The read-ahead command does not return the data to the host, and the write-ahead command does not write data to the flash address. The NAND flash controller loads the read data. The read data is returned to the host only when the host issues MAP01 commands to read the data. Similarly, the flash controller loads the write data, and writes it to the flash only when the host issues MAP01 commands to write the data.

A `pipe_cpyback_cmd_comp` interrupt is generated when the NAND flash controller has finished processing a pipeline command and has discarded that command from its queue. At this point of time, the host can send another pipeline command. A pipeline command is popped from the queue, and an interrupt is issued when the flash controller has started processing the last page of pipeline command. Hence, the `pipe_cpyback_cmd_comp` interrupt is issued prior to the last page load in case of pipeline read command and start of data transfer of the last page to be programmed in case of pipeline writes command.

An additional `program_comp` interrupt is generated when the last page program operation completes in case of pipeline write command.

If the device command set requires the NAND flash controller to issue a load command for the last page in the pipeline read command, a `load_comp` interrupt is generated after the last page load operation completes.

For pipeline write commands, if any page program results in a failure in the device, a `program_fail` interrupt is issued. The failing page's block and page address is updated in the `err_block_addr0` and `err_page_addr0` registers in the status group.

Pipeline commands sequence advanced commands in the device like cache and multi-plane. When the NAND flash controller receives a multi-page read or write pipeline command, it sequences commands sent to the device depending on settings in the following registers, in the `config` group:

- `cache_read_enable`
- `cache_write_enable`
- `multiplane_operation`

For a device that supports cache read sequences, the `flag` bit of the `cache_read_enable` register must be set to 1. The NAND flash controller sequences each multi-page pipeline read command as a cache read sequence. For a device that supports cache program command sequences, `cache_write_enable` must be set. The flash controller sequences each multi-page write pipeline command as a cache write sequence.

For a device that has multi-planes and supports multi-plane program commands, the NAND flash controller register `multiplane_operation`, in the `config` group, must be set. On receiving the multi-page pipeline write command, the flash controller sequences the device with multi-plane program commands and expects that the host transfers data to the flash controller in an even-odd block increment addressing mode.

Set Up a Single Area for Pipeline Read-Ahead

To set up an area for pipeline read-ahead, perform the following steps:

1. Write to the command register, setting the `CMD_MAP` field to 2 and the `BLK_ADDR` field to the starting address of the block to pre-read.
2. Write `0x20<PP>` to the Data register, where the 0 sets this command as a read-ahead and `<PP>` is the number of pages to pre-read. The pages must not cross a block boundary. If a block boundary is crossed, the NAND flash controller generates an unsupported command (`unsup_cmd`) interrupt and drops the command.

The read-ahead command is a hint to the flash device to start loading the next page in the page buffer as soon as the previous page buffer operation has completed. After you set up the read-ahead, use a `MAP01` command to actually read the data. In the `MAP01` command, specify the same starting address as in the read-ahead.

If the read command received following a pipeline read-ahead request is not to a pre-read page, then an interrupt bit is set to 1 and the pipeline read-ahead or write-ahead registers are cleared. You must issue a new pipeline read-ahead request must be issued to re-load the same data. You must use `MAP01` commands to read all of the data that is pre-read before the NAND flash controller returns to the idle state.

Set Up a Single Area for Pipeline Write-Ahead

To set up an area for pipeline write-ahead:


1. Write to the command register, setting the `CMD_MAP` field to 2 and the `BLK_ADDR` field to the starting address of the block to pre-write.
2. Write `0x21<PP>` to the Data register, where the value 1 sets this command as a write-ahead and `<PP>` is the number of pages to pre-write. The pages must not cross a block boundary. If a block boundary is crossed, the NAND flash controller generates an unsupported command (`unsup_cmd`) interrupt and drops the command.

After you set up the write-ahead, use a MAP01 command to actually write the data. In the MAP01 command, specify the same starting address as in the write-ahead.

If the write command received following a pipeline write-ahead request is not to a pre-written page, then an interrupt bit is set to 1 and the pipeline read-ahead or write-ahead registers are cleared. You must issue a new pipeline write-ahead request to configure the write logic.

You must use MAP01 commands to write all of the data that is pre-written before the NAND flash controller returns to the idle state.


NAND Flash Controller Address Map and Register Definitions

 The address map and register definitions reside in the [hps.html](#) file that accompanies this handbook volume. Click the link to open the file.

To view the module description and base address, scroll to and click the following links for the module instance:

- `nanddata`
- `nandregs`

To then view the register and field descriptions, scroll to and click the register names. The register addresses are offsets relative to the base address of each module instance.

 The base addresses of all modules are also listed in the *Introduction to the Hard Processor System* chapter in volume 3 of the *Cyclone V Device Handbook*.

Document Revision History


Table 10-18 lists the revision history for this document.

Table 10-18. Document Revision History

Date	Version	Changes
November 2012	1.2	<ul style="list-style-type: none"> ■ Supports one 8-bit device ■ Show additional supported block sizes ■ Bad block marker handling
May 2012	1.1	Added programming model section.
January 2012	1.0	Initial release.

The hard processor system (HPS) provides a Secure Digital/MultiMediaCard (SD/MMC) controller for interfacing to external SD and MMC flash cards, secure digital I/O (SDIO) devices, and Consumer Electronics Advanced Transport Architecture (CE-ATA) hard drives. The SD/MMC controller enables you to store boot images and boot the processor system from the removable flash card. You can also use the flash card to expand the on-board storage capacity for larger applications or user data. Other applications include interfacing to embedded SD (eSD) and embedded MMC (eMMC) nonremovable flash devices.

The SD/MMC controller is based on the Synopsys® DesignWare® Mobile Storage Host (DWC_mobile_storage) controller.

 This document refers to SD/SDIO commands, which are documented in detail in the *Physical Layer Simplified Specification, Version 3.01* and the *SDIO Simplified Specification Version 2.00* as described in “References” on page 11–79.

Features of the SD/MMC Controller

The HPS SD/MMC controller offers the following features:

- Supports HPS boot from mobile storage
- Supports the following standards or card types:
 - SD, including eSD—version 3.0
 - SDIO, including embedded SDIO (eSDIO)—version 3.0
 - CE-ATA—version 1.1
 - MMC, including eMMC—version 4.41, 1-bit, 4-bit, and 8-bit (in some packages, as described in Table 11–2 on page 11–3)
- Integrated descriptor-based direct memory access (DMA)
- Internal 4 KB receive and transmit FIFO buffer

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Table 11-1 shows various SD card device types and the supported voltages, bus modes, and speeds.

The SD/MMC controller does not directly support voltage switching, card interrupts, or back-end power control of eSDIO card devices. However, you can connect these signals to general-purpose I/Os (GPIOs).

Table 11-1. SD Card Use Cases

Card Device Type	Voltages Supported		Bus Modes Supported				Bus Speed Modes Supported			
							Default Speed	High Speed	SDR12	SDR25 ⁽¹⁾
	3.3 V	1.8 V	SPI	1 bit	4 bit	8 bit	12.5 MBps 25 MHz	25 MBps 50 MHz	12.5 MBps 25 MHz	25 MBps 50 MHz
SDSC (SD)	✓	—	✓	✓	—	—	✓	✓	—	—
SDHC	✓	✓ ⁽²⁾	✓	✓	✓	—	✓	✓	✓	✓
SDXC	✓	✓ ⁽²⁾	✓	✓	✓	—	✓	✓	✓	✓
eSD	✓	✓ ⁽²⁾	✓	✓	✓	—	✓	✓	✓	✓
SDIO	✓	✓ ⁽²⁾	✓	✓	✓	—	✓	✓	✓	✓
eSDIO	✓	✓ ⁽²⁾	✓	✓	✓	✓ ⁽³⁾	✓	✓	✓	✓

Notes to Table 11-1:

- (1) SDR25 speed mode requires 1.8-V signaling. Note that even if a card supports UHS-I modes (for example SDR50, SDR104, DDR50) it can still communicate at the lower speeds (for example SDR12, SDR25).
- (2) Controls the voltage switch output to support 1.8-V signalling for SD.
- (3) Optional 8-bit bus mode for eSDIO is not supported in all FPGA packages.



Card form factors (such as mini and micro) are not enumerated in Table 11-1 because they do not impact the card interface functionality.

Table 11-2 shows various MMC card device types and the supported voltage, bus modes, and bus speeds.

The SD/MMC controller does not contain a reset output as part of the external card interface. To reset the flash card device, consider using a general purpose output pin.

Table 11-2. MMC Use Cases

Card Device Type	Max Clock Speed (MHz)	Max Data Rate (MBps)	Voltages Supported		Bus Modes Supported				Bus Speed Modes Supported	
			3.3 V	1.8 V	SPI ⁽¹⁾	1 bit	4 bit	8 bit	Default Speed	High Speed
MMC	20	2.5	✓	—	✓	✓	—	—	✓	—
RSMMC	20	10	✓	—	✓	✓	✓	—	✓	✓
MMCPPlus	50 ⁽³⁾	25	✓	—	—	✓	✓	✓ ⁽²⁾	✓	✓
MMCMobile	50	6.5	✓	✓	—	✓	—	—	✓	✓
eMMC	50	25	✓	✓	—	✓	✓	—	✓	✓

Notes to Table 11-2:

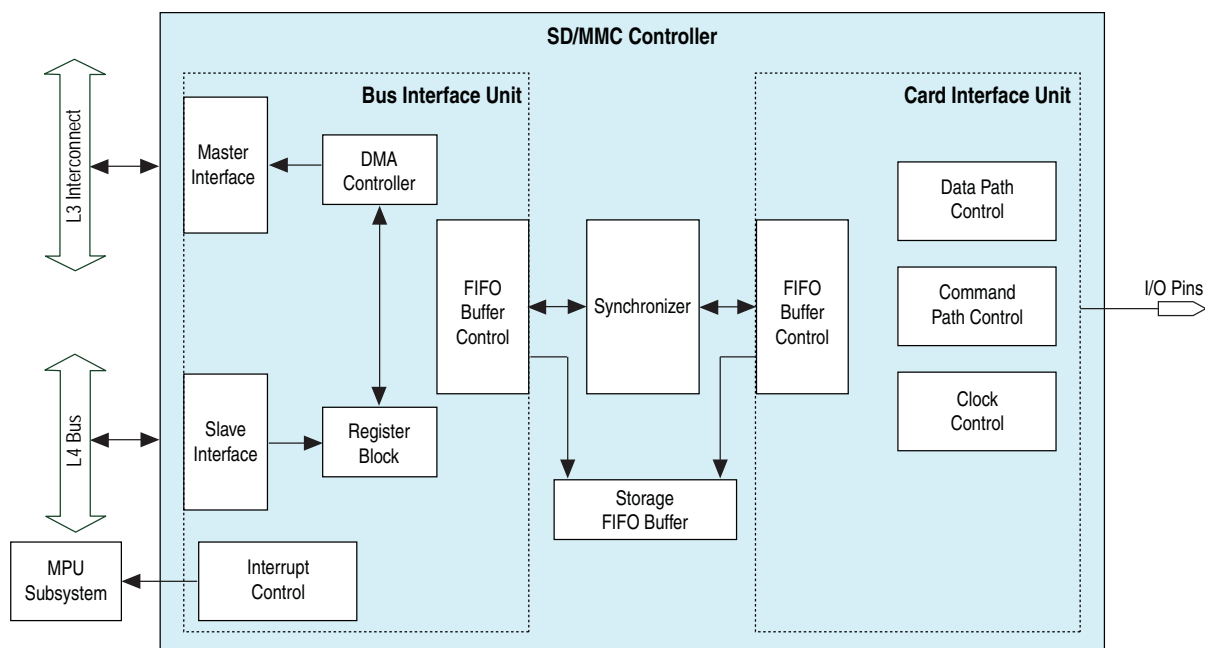
- (1) SPI mode is obsolete in the MMC 4.41 specification.
- (2) The optional 8-bit bus mode is not supported in all FPGA packages.
- (3) Supports a maximum clock rate of 50 MHz instead of 52 MHz (specified in MMC specification).

SD/MMC Controller Block Diagram and System Integration

The SD/MMC controller includes a bus interface unit (BIU) and a card interface unit (CIU). The BIU provides a slave interface for a host to access the control and status registers (CSRs). Additionally, this unit also provides independent FIFO buffer access through a DMA interface. The DMA controller is responsible for exchanging data between the system memory and FIFO buffer. The DMA registers are accessible by the host to control the DMA operation. The CIU supports the SD, MMC, and CE-ATA protocols on the controller, and provides clock management through the clock control block. The interrupt control block for generating an interrupt connects to the generic interrupt controller in the ARM® Cortex™-A9 microprocessor unit (MPU) subsystem.

Figure 11-1 shows a block diagram of the SD/MMC controller and how it integrates in the HPS.

Figure 11-1. SD/MMC Controller Connectivity



Functional Description of the SD/MMC Controller

This section describes the SD/MMC controller components and how the controller operates.

SD/MMC/CE-ATA Protocol

The SD/MMC/CE-ATA protocol is based on command and data bit streams that are initiated by a start bit and terminated by a stop bit. Additionally, the SD/MMC controller provides a reference clock and is the only master interface that can initiate a transaction.

- **Command**—a token transmitted serially on the **CMD** pin that starts an operation.
- **Response**—a token from the card transmitted serially on the **CMD** pin in response to certain commands.
- **Data**—transferred serially using the data pins for data movement commands.

Figure 11-2 illustrates an example of a multiple-block read operation. The clock is a representative only and does not show the exact number of clock cycles.

Figure 11-2. Multiple-Block Read Operation

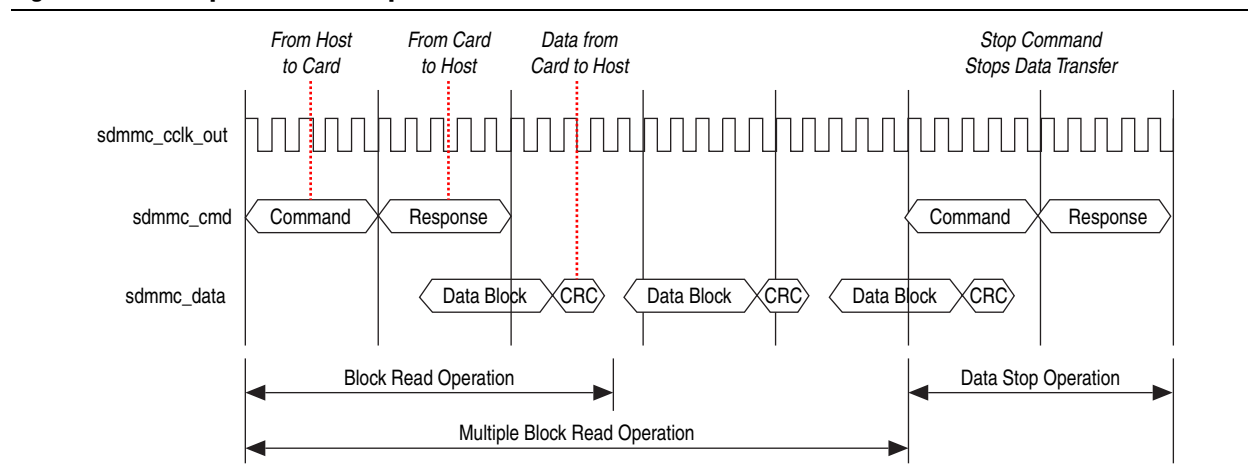
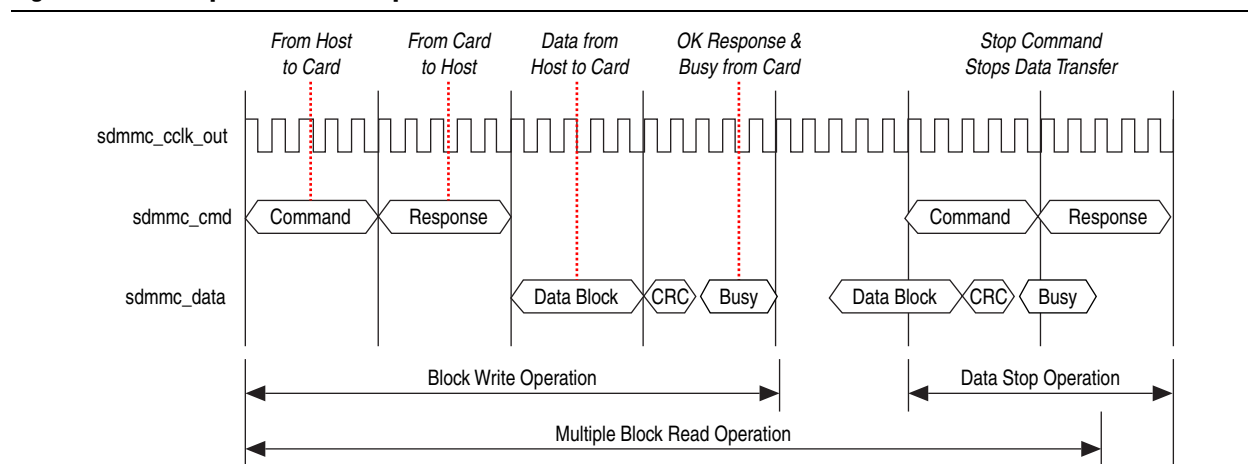


Figure 11-3 illustrates an example of a command token sent by the host in a multiple-block write operation.

Figure 11-3. Multiple-Block Write Operation



BIU

The BIU interfaces with the CIU, and is connected to the level 3 (L3) interconnect and level 4 (L4) peripheral buses. The BIU consists of the following primary functional blocks:

- Slave interface
- Register block
- FIFO buffer
- Internal DMA controller

Slave Interface

The host processor accesses the SD/MMC controller registers and data FIFO buffers through the slave interface.

Register Block

The register block is part of the BIU and provides read and write access to the CSRs.

All registers reside in the BIU clock domain. When a command is sent to a card by setting the start command bit (`start_cmd`) of the command register (`cmd`) to 1, all relevant registers needed for the CIU operation are transferred to the CIU block. During this time, software must not write to the registers that are transferred from the BIU to the CIU. The software must wait for the hardware to reset the `start_cmd` bit to 0 before writing to these registers again. The register unit has a hardware locking feature to prevent illegal writes to registers.

After a command start is issued by setting the `start_cmd` bit of the `cmd` register, the following registers cannot be rewritten until the command is accepted by the CIU:

- Command (`cmd`)
- Command argument (`cmdarg`)
- Byte count (`bytcnt`)
- Block size (`blksiz`)
- Clock divider (`clkdiv`)
- Clock enable (`clkena`)
- Clock source (`clksrc`)
- Timeout (`tmout`)
- Card type (`ctype`)

The hardware resets the `start_cmd` bit once the CIU accepts the command. If a host write to any of these registers is attempted during this locked time, the write is ignored and the hardware lock write error bit (`hle`) is set to 1 in the raw interrupt status register (`rintsts`). Additionally, if the interrupt is enabled and not masked for a hardware lock error, an interrupt is sent to the host.

After a command is accepted, you can send another command to the CIU—which has a one-deep command queue—under the following conditions:

- If the previous command is not a data transfer command, the new command is sent to the SD/MMC/CE-ATA card once the previous command completes.
- If the previous command is a data transfer command and if the wait previous data complete bit (`wait_prvdata_complete`) of the `cmd` register is set to 1 for the new command, the new command is sent to the SD/MMC/CE-ATA card only when the data transfer completes.
- If the `wait_prvdata_complete` bit is 0, the new command is sent to the SD/MMC/CE-ATA card as soon as the previous command is sent. Typically, use this feature to stop or abort a previous data transfer or query the card status in the middle of a data transfer.

Interrupt Controller Unit

The interrupt controller unit generates an interrupt that depends on the `rintsts` register, the interrupt mask register (`intmask`), and the interrupt enable bit (`int_enable`) of the control register (`ctrl`). Once an interrupt condition is detected, the controller sets the corresponding interrupt bit in the `rintsts` register. The bit in the `rintsts` register remains set to 1 until the software resets the bit to 0 by writing a 1 to the interrupt bit; writing a 0 leaves the bit untouched.

The interrupt port is an active-high, level-sensitive interrupt. The interrupt port is active only when at least one bit in the `rintsts` register is set to 1, the corresponding `intmask` register bit is 1, and the `int_enable` bit of the `ctrl` register is 1.

The following bits are available as top-level ports for debug purposes:

- All bits of the `intmask` register
- All bits of the `rintsts` register
- The `int_enable` bit of the `ctrl` register

The `int_enable` bit of the `ctrl` register is set to 0 on power-on, and the `intmask` register bits are set to 0x0000000, which masks all the interrupts.

The following conditions can cause the interrupt to occur:

- End-bit error on read
- No cyclic redundancy code (CRC) on write
- Auto command done
- Start-bit error
- Hardware locked write error
- FIFO buffer underflow or overflow error
- Data starvation by host timeout
- Data read timeout or boot data start
- Response timeout or boot ACK received
- Data CRC error
- Response CRC error

- Receive FIFO buffer data request
- Transmit FIFO buffer data request
- Data transfer over
- Command done
- Response error

The Receive FIFO Data Request and Transmit FIFO Data Request interrupts are set by level-sensitive interrupt sources. Therefore, the interrupt source must be first cleared before you can reset the interrupt's corresponding bit in the `rintsts` register to 0.

For example, on receiving the Receive FIFO Data Request interrupt, the FIFO buffer must be emptied so that the FIFO buffer count is not greater than the RX watermark, which causes the interrupt to be triggered.

The rest of the interrupts are triggered by single clock-pulse-width sources.

FIFO Buffer

The SD/MMC controller has a 4-KB data FIFO buffer for storing transmit and receive data. The FIFO buffer memory supports error correction codes (ECCs). Both interfaces to the FIFO buffer support single and double bit error injection. The enable and error injection pins are inputs driven by the system manager and the status pins are outputs driven to the MPU subsystem.

The SD/MMC controller provides outputs to notify the system manager when single-bit correctable errors are detected (and corrected), and when double-bit (uncorrectable) errors are detected. The system manager generates an interrupt to the GIC when an ECC error is detected.



For more information, refer to the *System Manager* chapter in volume 3 of the *Cyclone® V Device Handbook*.

Internal DMA Controller

The internal DMA controller has a CSR and a single transmit or receive engine, which transfers data from system memory to the card and vice versa. The controller uses a descriptor mechanism to efficiently move data from source to destination with minimal host processor intervention. You can set up the controller to interrupt the host processor in situations such as transmit and receive data transfer completion from the card, as well as other normal or error conditions. The DMA controller and the host driver communicate through a single data structure.

The internal DMA controller transfers the data received from the card to the data buffer in the system memory, and transfers transmit data from the data buffer in the memory to the controller's FIFO buffer. Descriptors that reside in the system memory act as pointers to these buffers.

A data buffer resides in the physical memory space of the system memory and consists of complete or partial data. The buffer status is maintained in the descriptor. Data chaining refers to data that spans multiple data buffers. However, a single descriptor cannot span multiple data buffers.

A single descriptor is used for both reception and transmission. The base address of the list is written into the descriptor list base address register (dbaddr). A descriptor list is forward linked. The last descriptor can point back to the first entry to create a ring structure. The descriptor list resides in the physical memory address space of the host. Each descriptor can point to a maximum of two data buffers.

Internal DMA Controller Descriptors

The internal DMA controller uses these types of descriptor structures:

- Dual-buffer structure—The distance between two descriptors is determined by the skip length value written to the descriptor skip length field (dsl) of the bus mode register (bmod).
- Chain structure—Each descriptor points to a unique buffer, and to the next descriptor in a linked list.

Figure 11-4 and Figure 11-5 illustrate the internal DMA controller dual-buffer descriptor structure and chain descriptor structure respectively.

Figure 11-4. Dual-Buffer Descriptor Structure

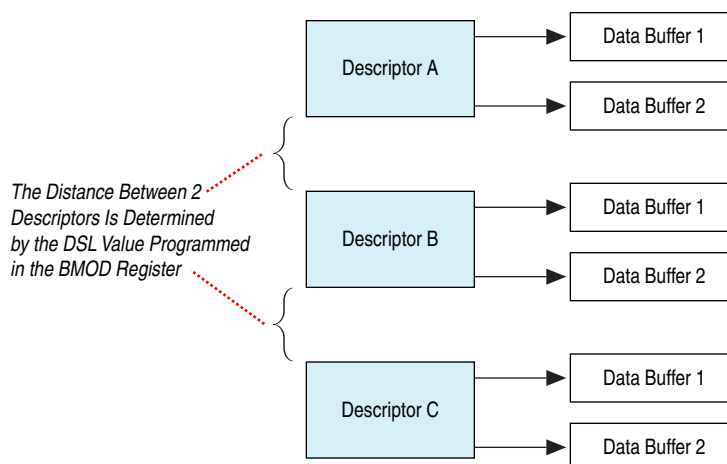


Figure 11-5. Chain Descriptor Structure

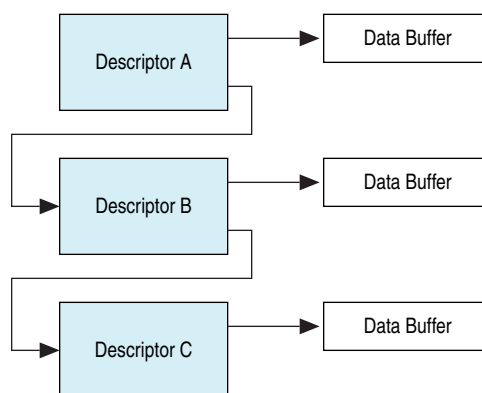


Table 11-3 shows the internal format of a descriptor. The descriptor address must be aligned to the 32-bit bus. Each descriptor contains 16 bytes of control and status information. For information about each of the bits of the descriptor, refer to Table 11-4 on page 11-11 through Table 11-7 on page 11-12.

Table 11-3. Descriptor Format

Name	Offset	31	30	29	...	26	25	...	13	12	...	6	5	4	3	2	1	0	
DES0	0	OWN	CES	—										ER	CH	FS	LD	DIC	—
DES1	4	—					BS2					BS1							
DES2	8	BAP1																	
DES3	12	BAP2 or Next Descriptor Address																	

The DES0 field in the internal DMA controller descriptor contains control and status information. Table 11-4 lists the bits in this descriptor.

Table 11-4. Internal DMA Controller DES0 Descriptor Field

Bits	Name	Description
31	OWN	When set to 1, this bit indicates that the descriptor is owned by the internal DMA controller. When this bit is set to 0, it indicates that the descriptor is owned by the host. The internal DMA controller resets this bit to 0 when it completes the data transfer.
30	Card Error Summary (CES)	The CES bit indicates whether a transaction error occurred. The CES bit is the logical OR of the following error bits in the <code>rintsts</code> register. <ul style="list-style-type: none"> ■ End-bit error (<code>ebe</code>) ■ Response timeout (<code>rto</code>) ■ Response CRC (<code>rcrc</code>) ■ Start-bit error (<code>sbe</code>) ■ Data read timeout (<code>drto</code>) ■ Data CRC for receive (<code>dcrc</code>) ■ Response error (<code>re</code>)
29:6	Reserved	—
5	End of Ring (ER)	When set to 1, this bit indicates that the descriptor list reached its final descriptor. The internal DMA controller returns to the base address of the list, creating a descriptor ring. ER is meaningful for only a dual-buffer descriptor structure.
4	Second Address Chained (CH)	When set to 1, this bit indicates that the second address in the descriptor is the next descriptor address rather than the second buffer address. When this bit is set to 1, BS2 (DES1[25:13]) must be all zeros.
3	First Descriptor (FS)	When set to 1, this bit indicates that this descriptor contains the first buffer of the data. If the size of the first buffer is 0, next descriptor contains the beginning of the data.
2	Last Descriptor (LD)	When set to 1, this bit indicates that the buffers pointed to by this descriptor are the last buffers of the data.
1	Disable Interrupt on Completion (DIC)	When set to 1, this bit prevents the setting of the TI/RI bit of the internal DMA controller status register (<code>idsts</code>) for the data that ends in the buffer pointed to by this descriptor.
0	Reserved	—

The DES1 descriptor field contains the buffer size. Table 11-5 lists the bits in this descriptor.

Table 11-5. Internal DMA Controller DES1 Descriptor Field

Bits	Name	Description
31:26	Reserved	—
25:13	Buffer 2 Size (BS2)	These bits indicate the second data buffer byte size. The buffer size must be a multiple of four. When the buffer size is not a multiple of four, the resulting behavior is undefined. This field is not valid if DES0[4] is set to 1.
12:0	Buffer 1 Size (BS1)	Indicates the data buffer byte size, which must be a multiple of four bytes. When the buffer size is not a multiple of four, the resulting behavior is undefined. If this field is 0, the DMA ignores the buffer and proceeds to the next descriptor for a chain structure, or to the next buffer for a dual-buffer structure. If there is only one descriptor and only one buffer to be programmed, you need to use only buffer 1 and not buffer 2.

The DES2 descriptor field contains the address pointer to the data buffer. Table 11-6 lists the bits in this descriptor.

Table 11-6. Internal DMA Controller DES2 Descriptor Field

Bits	Name	Description
31:0	Buffer Address Pointer 1 (BAP1)	These bits indicate the physical address of the first data buffer. The internal DMA controller ignores DES2 [1:0], because it only performs 32-bit-aligned accesses.

The DES3 descriptor field contains the address pointer to the next descriptor if the present descriptor is not the last descriptor in a chained descriptor structure or the second buffer address for a dual-buffer structure. Table 11-7 lists the bits in this descriptor.

Table 11-7. Internal DMA Controller DES3 Descriptor Field

Bits	Name	Description
31:0	Buffer Address Pointer 2 (BAP2) or Next Descriptor Address	These bits indicate the physical address of the second buffer when the dual-buffer structure is used. If the Second Address Chained (DES0[4]) bit is set to 1, this address contains the pointer to the physical memory where the next descriptor is present. If this is not the last descriptor, the next descriptor address pointer must be aligned to 32 bits. Bits 1 and 0 are ignored.

Host Bus Burst Access

The internal DMA controller attempts to execute fixed-length burst transfers on the master interface if configured using the fixed burst bit (*fb*) of the *bmod* register. The maximum burst length is indicated and limited by the programmable burst length (*pb1*) field of the *bmod* register. When descriptors are being fetched, the master interface always presents a burst size of four to the interconnect.

The internal DMA controller initiates a data transfer only when sufficient space to accommodate the configured burst is available in the FIFO buffer or the number of bytes to the end of transfer is less than the configured burst-length. When the DMA master interface is configured for fixed-length bursts, it transfers data using the most efficient combination of INCR4/8/16 and SINGLE transactions. If the DMA master interface is not configured for fixed length bursts, it transfers data using INCR (undefined length) and SINGLE transactions.

Host Data Buffer Alignment

The transmit and receive data buffers in system memory must be aligned to a 32-bit boundary.

Buffer Size Calculations

The driver knows the amount of data to transmit or receive. For transmitting to the card, the internal DMA controller transfers the exact number of bytes from the FIFO buffer, indicated by the buffer size field of the DES1 descriptor field.

If a descriptor is not marked as last (with the LD bit of the DES0 field set to 0) then the corresponding buffer(s) of the descriptor are considered full, and the amount of valid data in a buffer is accurately indicated by its buffer size field. If a descriptor is marked as last, the buffer might or might not be full, as indicated by the buffer size in the DES1 field. The driver is aware of the number of locations that are valid. The driver is expected to ignore the remaining, invalid bytes.

Internal DMA Controller Interrupts

Interrupts can be generated as a result of various events. The *idsts* register contains all the bits that might cause an interrupt. The internal DMA controller interrupt enable register (*idinten*) contains an enable bit for each of the events that can cause an interrupt to occur.

There are two summary interrupts—the normal interrupt summary bit (*nis*) and the abnormal interrupt summary bit (*ais*)—in the *idsts* register. The *nis* bit results from a logical OR of the transmit interrupt (*ti*) and receive interrupt (*ri*) bits in the *idsts* register. The *ais* bit is a logical OR result of the fatal bus error interrupt (*fbe*), descriptor unavailable interrupt (*du*), and card error summary interrupt (*ces*) bits in the *idsts* register.

Interrupts are cleared by writing a 1 to the corresponding bit position. If a 0 is written to an interrupt's bit position, the write is ignored, and does not clear the interrupt. When all the enabled interrupts within a group are cleared, the corresponding summary bit is set to 0. When both the summary bits are set to 0, the interrupt signal is de-asserted.

Interrupts are not queued. If another interrupt event occurs before the driver has responded to the previous interrupt, no additional interrupts are generated. For example, the `ri` bit of the `idsts` register indicates that one or more data has been transferred to the host buffer.

An interrupt is generated only once for simultaneous, multiple events. The driver must scan the `idsts` register for the interrupt cause. The final interrupt signal from the controller is a logical OR of the interrupts from the BIU and internal DMA controller.

Internal DMA Controller FSM

The following steps show the internal DMA controller functional state machine (FSM) operations:

1. The internal DMA controller performs four accesses to fetch a descriptor.
2. The DMA controller stores the descriptor information internally. If it is the first descriptor, the controller issues a FIFO buffer reset and waits until the reset is complete.
3. The internal DMA controller checks each bit of the descriptor for the correctness. If bit mismatches are found, the appropriate error bit is set to 1 and the descriptor is closed by setting the `OWN` bit in the `DES0` field to 1.

The `rintsts` register indicates one of the following conditions:

- Response timeout
 - Response CRC error
 - Data receive timeout
 - Response error
4. The DMA waits for the RX watermark to be reached before writing data to system memory, or the TX watermark to be reached before reading data from system memory. The RX watermark represents the number of bytes to be locally stored in the FIFO buffer before the DMA writes to memory. The TX watermark represents the number of free bytes in the local FIFO buffer before the DMA reads data from memory.
 5. If the value of the programmable burst length (PBL) field is larger than the remaining amount of data in the buffer, single transfers are initiated. If dual buffers are being used, and the second buffer contains no data (buffer size = 0), the buffer is skipped and the descriptor is closed.
 6. The `OWN` bit in descriptor is set to 0 by the internal DMA controller after the data transfer for one descriptor is completed. If the transfer spans more than one descriptor, the DMA controller fetches the next descriptor. If the transfer ends with the current descriptor, the internal DMA controller goes to idle state after setting the `ri` bit or the `ti` bit of the `idsts` register. Depending on the descriptor structure (dual buffer or chained), the appropriate starting address of descriptor is loaded. If it is the second data buffer of dual buffer descriptor, the descriptor is not fetched again.

Abort During Internal DMA Transfer

If the host issues an SD/SDIO STOP_TRANSMISSION command (CMD12) to the card while data transfer is in progress, the internal DMA controller closes the present descriptor after completing the data transfer until a Data Transfer Over (DTO) interrupt is asserted. Once a STOP_TRANSMISSION command is issued, the DMA controller performs single burst transfers.

1. For a card write operation, the internal DMA controller keeps writing data to the FIFO buffer after fetching it from the system memory until a DTO interrupt is asserted. This is done to keep the card clock running so that the STOP_TRANSMISSION command is reliably sent to the card.
2. For a card read operation, the internal DMA controller keeps reading data from the FIFO buffer and writes to the system memory until a DTO interrupt is generated. This is required because DTO interrupt is not generated until and unless all the FIFO buffer data is emptied.



For a card write abort, only the current descriptor during which a STOP_TRANSMISSION command is issued is closed by the internal DMA controller. The remaining unread descriptors are not closed by the internal DMA controller.



For a card read abort, the internal DMA controller reads the data out of the FIFO buffer and writes them to the corresponding descriptor data buffers. The remaining unread descriptors are not closed.

FIFO Buffer Overflow and Underflow

During normal data transfer conditions, FIFO buffer overflow and underflow does not occur. However, if there is a programming error, a FIFO buffer overflow or underflow can result. For example, consider the following scenarios.

For transmit:

- PBL=4
- TX watermark = 1

For these programming values, if the FIFO buffer has only one location empty, the DMA attempts to read four words from memory even though there is only one word of storage available. This results in a FIFO Buffer Overflow interrupt.

For receive:

- PBL=4
- RX watermark = 1

For these programming values, if the FIFO buffer has only one location filled, the DMA attempts to write four words, even though only one word is available. This results in a FIFO Buffer Underflow interrupt.

The driver must ensure that the number of bytes to be transferred, as indicated in the descriptor, is a multiple of four bytes. For example, if the `bytcnt` register = 13, the number of bytes indicated in the descriptor must be rounded up to 16 because the length field must always be a multiple of four bytes.

Table 11-8 lists the legal PBL and FIFO buffer watermark values for internal DMA controller data transfers operations.

Table 11-8. PBL and Watermark Levels

PBL (Number of transfers)	TX/RX Watermark Value
1	greater than or equal to 1
4	greater than or equal to 4
8	greater than or equal to 8
16	greater than or equal to 16
32	greater than or equal to 32
64	greater than or equal to 64
128	greater than or equal to 128
256	greater than or equal to 256

Fatal Bus Error Scenarios

A fatal bus error occurs due to an error response through the master interface. This error is a system error, so the software driver must not perform any further setup on the controller. The only recovery mechanism from such scenarios is to perform one of the following tasks:

- Issue a reset to the controller through the reset manager.
- Issue a program controller reset by writing to the controller reset bit (`controller_reset`) of the `ctrl` register.

CIU

The CIU interfaces with the BIU and SD/MMC cards or devices. The host processor writes command parameters to the SD/MMC controller's BIU control registers and these parameters are then passed to the CIU. Depending on control register values, the CIU generates SD/MMC command and data traffic on the card bus according to the SD/MMC protocol. The control register values also decide whether the command and data traffic is directed to the CE-ATA card, and the SD/MMC controller controls the command and data path accordingly.

The following list describes the CIU operation restrictions:

- After a command is issued, the CIU accepts another command only to check read status or to stop the transfer.
- Only one data transfer command can be issued at a time.
- During an open-ended card write operation, if the card clock is stopped because the FIFO buffer is empty, the software must first fill the data into the FIFO buffer and start the card clock. It can then issue only an SD/SDIO STOP_TRANSMISSION (CMD12) command to the card.
- During an SDIO/COMBO card transfer, if the card function is suspended and the software wants to resume the suspended transfer, it must first reset the FIFO buffer and start the resume command as if it were a new data transfer command.

- When issuing SD/SDIO card reset commands (GO_IDLE_STATE, GO_INACTIVE_STATE or CMD52_reset) while a card data transfer is in progress, the software must set the stop abort command bit (stop_abort_cmd) in the cmd register to 1 so that the controller can stop the data transfer after issuing the card reset command.
- If the card clock is stopped because the FIFO buffer is full during a card read, the software must read at least two FIFO buffer locations to start the card clock.
- If CE-ATA card device interrupts are enabled (the nIEN bit is set to 0 in the ATA control register), a new RW_BLK command must not be sent to the same card device if there is a pending RW_BLK command in progress (the RW_BLK command used in this document is the RW_MULTIPLE_BLOCK MMC command defined by the CE-ATA specification). Only the Command Completion Signal Disable (CCSD) command can be sent while waiting for the Command Completion Signal (CCS).
- For the same card device, a new command is allowed for reading status information, if interrupts are disabled in the CE-ATA card (the nIEN bit is set to 1 in the ATA control register).
- Open-ended transfers are not supported for the CE-ATA card devices.
- The send_auto_stop signal is not supported (software must not set the send_auto_stop bit in the cmd register) for CE-ATA transfers.

The CIU consists of the following primary functional blocks:

- Command path
- Data path
- Clock control

Command Path

The command path performs the following functions:

- Load card command parameters
- Send commands to card bus
- Receive responses from card bus
- Send responses to BIU
- Load clock parameters
- Drives the P-bit on command pin

A new command is issued to the controller by writing to the BIU registers and setting the start_cmd bit in the cmd register. The command path loads the new command (command, command argument, timeout) and sends an acknowledgement to the BIU.

After the new command is loaded, the command path state machine sends a command to the card bus—including the internally generated seven-term CRC (CRC-7)—and receives a response, if any. The state machine then sends the received response and signals to the BIU that the command is done, and then waits for eight clock cycles before loading a new command. In CE-ATA data payload transfer (RW_MULTIPLE_BLOCK) commands, if the card device interrupts are enabled (the nIEN bit is set to 0 in the ATA control register), the state machine performs the following actions after receiving the response:

- Does not drive the P-bit; it waits for CCS, decodes and goes back to idle state, and then drives the P-bit.
- If the host wants to send the CCSD command and if eight clock cycles are expired after the response, it sends the CCSD pattern on the command pin.

Load Command Parameters

Commands or responses are loaded in the command path in the following situations:

- New command from BIU—When the BIU sends a new command to the CIU, the `start_cmd` bit is set to 1 in the `cmd` register.
- Internally-generated `send_auto_stop`—When the data path ends, the SD/SDIO STOP command request is loaded.
- Interrupt request (IRQ) response with relative card address (RCA) 0x000—When the command path is waiting for an IRQ response from the MMC and a “send irq response” request is signaled by the BIU, the `send_irq` request bit (`send_irq_response`) is set to 1 in the `ctrl` register.

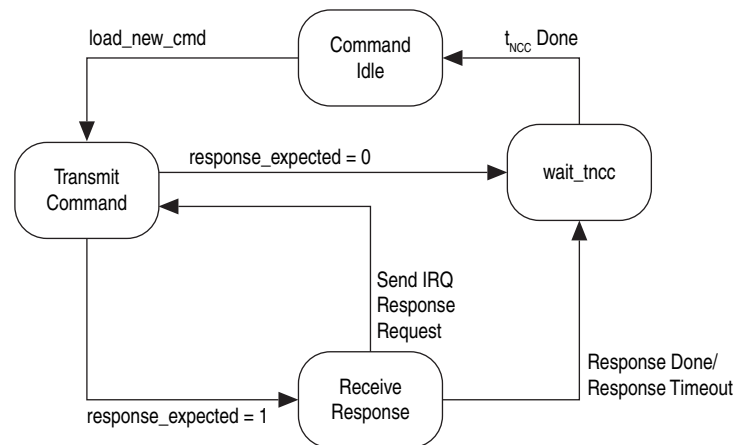
Loading a new command from the BIU in the command path depends on the following `cmd` register bit settings:

- `update_clock_registers_only`—If this bit is set to 1 in the `cmd` register, the command path updates only the `clkena`, `clkdiv`, and `clksrc` registers. If this bit is set to 0, the command path loads the `cmd`, `cmdarg`, and `tmout` registers. It then processes the new command, which is sent to the card.
- `wait_prvdata_complete`—If this bit is set to 1, the command path loads the new command under one of the following conditions:
 - Immediately, if the data path is free (that is, there is no data transfer in progress), or if an open-ended data transfer is in progress (`bytcnt = 0`).
 - After completion of the current data transfer, if a predefined data transfer is in progress.

Send Command and Receive Response

After a new command is loaded in the command path (the `update_clock_registers_only` bit in the `cmd` register is set to 0), the command path state machine sends out a command on the card bus. Figure 11-6 illustrates the command path state machine.

Figure 11-6. Command Path State Machine



The command path state machine performs the following functions, according to `cmd` register bit values:

1. `send_initialization`—Initialization sequence of 80 clock cycles is sent before sending the command.
2. `response_expected`—A response is expected for the command. After the command is sent out, the command path state machine receives a 48-bit or 136-bit response and sends it to the BIU. If the start bit of the card response is not received within the number of clock cycles (as set up in the `tmout` register), the `rto` bit and command done (CD) bit are set to 1 in the `rintsts` register, to signal to the BIU. If the response-expected bit is set to 0, the command path sends out a command and signals a response done to the BIU, which causes the `cmd` bit to be set to 1 in the `rintsts` register.
3. `response_length`—If this bit is set to 1, a 136-bit long response is received; if it is set to 0, a 48-bit short response is received.
4. `check_response_crc`—If this bit is set to 1, the command path compares CRC-7 received in the response with the internally-generated CRC-7. If the two do not match, the response CRC error is signaled to the BIU, that is, the `rcrc` bit is set to 1 in the `rintsts` register.

Send Response to BIU

If the `response_expected` bit is set to 1 in the `cmd` register, the received response is sent to the BIU. Response register 0 (`resp0`) is updated for a short response, and the response register 3 (`resp3`), response register 2 (`resp2`), response register 1 (`resp1`), and `resp0` registers are updated on a long response, after which the `cmd` bit is set to 1 in the `rintsts` register. If the response is for an `AUTO_STOP` command sent by the CIU, the response is written to the `resp1` register, after which the auto command done bit (`acd`) is set to 1 in the `rintsts` register.

A correct card response contains the fields listed in Table 11-9. The command path verifies the contents of the card response.

Table 11-9. Card Response Fields

Field	Contents
Response transmission bit	0
Command index	Command index of the sent command
End bit	1

The command index is not checked for a 136-bit response or if the `check_response_crc` bit in the `cmd` register is set to 0. For a 136-bit response and reserved CRC 48-bit responses, the command index is reserved, that is, 0b111111.

For more information about response values, refer to *Physical Layer Simplified Specification, Version 3.01* as described in “References” on page 11-79.

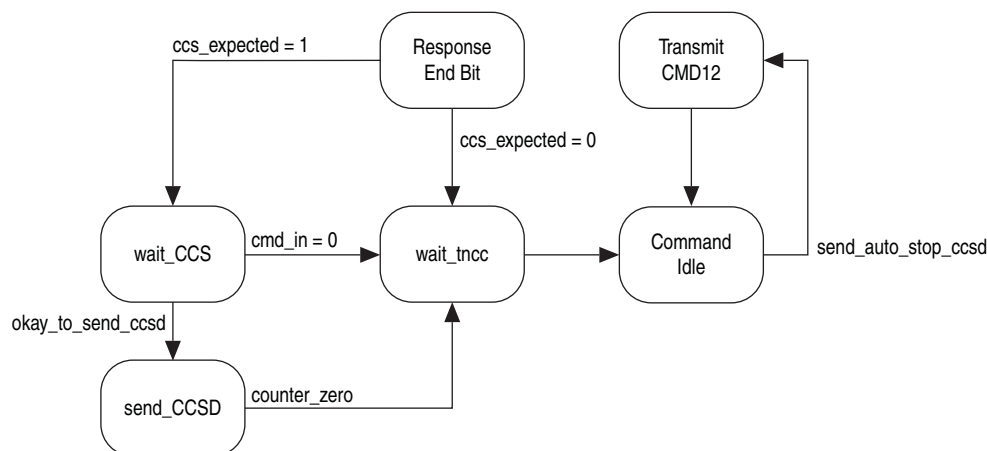
Driving P-bit on CMD Line

The command path drives a one-cycle pull-up bit (P-bit) to 1 on the CMD line between two commands if a response is not expected. If a response is expected, the P-bit is driven after the response is received and before the start of the next command. While accessing a CE-ATA card device, for commands that expect a CCS, the P-bit is driven after the response only if the interrupts are disabled in the CE-ATA card (the `nIEN` bit is set to 1 in the ATA control register), that is, the CCS expected bit (`ccs_expected`) in the `cmd` register is set to 0. If the command expects the CCS, the P-bit is driven only after receiving the CCS.

Polling the CCS

CE-ATA card devices generate the CCS to notify the host controller of the normal ATA command completion or ATA command termination. After receiving the response from the card, the command path state machine performs the functions illustrated in Figure 11-7 according to `cmd` register bit values.

Figure 11-7. CE-ATA Command Path State Machine



The following describe some of the details in [Figure 11-7](#):

1. Response end bit state—The state machine receives the end bit of the response from the card device. If the `ccs_expected` bit of the `cmd` register is set to 1, the state machine enters the wait CCS state.
2. Wait CCS—The state machine waits for the CCS from the CE-ATA card device. While waiting for the CCS, the following events can happen:
 - a. Software sets the send CCSD bit (`send_ccsd`) in the `ctrl` register, indicating not to wait for CCS and to send the CCSD pattern on the command line.
 - b. Receive the CCS on the CMD line.
3. Send CCSD command—Sends the CCSD pattern (0b00001) on the CMD line.

CCS Detection and Interrupt to Host Processor

If the `ccs_expected` bit in the `cmd` register is set to 1, the CCS from the CE-ATA card device is indicated by setting the data transfer over bit (`dto`) in the `rintsts` register. The controller generates a DTO interrupt if this interrupt is not masked.

For the `RW_MULTIPLE_BLOCK` commands, if the CE-ATA card device interrupts are disabled (the `nIEN` bit is set to 1 in the ATA control register)—that is, the `ccs_expected` bit is set to 0 in the `cmd` register—there are no CCSs from the card. When the data transfer is over—that is, when the requested number of bytes are transferred—the `dto` bit in the `rintsts` register is set to 1.

CCS Timeout

If the command expects a CCS from the card device (the `ccs_expected` bit is set to 1 in the `cmd` register), the command state machine waits for the CCS and remains in the wait CCS state. If the CE-ATA card fails to send out the CCS, the host software must implement a timeout mechanism to free the command and data path. The controller does not implement a hardware timer; it is the responsibility of the host software to maintain a software timer.

In the event of a CCS timeout, the host must issue a CCSD command by setting the `send_ccsd` bit in the `ctrl` register. The controller command path state machine sends the CCSD command to the CE-ATA card device and exits to an idle state. After sending the CCSD command, the host must also send an SD/SDIO `STOP_TRANSMISSION` command to the CE-ATA card to abort the outstanding ATA command.

Send CCSD Command

If the `send_ccsd` bit in the `ctrl` register is set to 1, the controller sends a CCSD pattern on the CMD line. The host can send the CCSD command while waiting for the CCS or after a CCS timeout happens.

After sending the CCSD pattern, the controller sets the `cmd` bit in the `rintsts` register and also generates an interrupt to the host if the Command Done interrupt is not masked.



Within the CIU block, if the `send_ccsd` bit in the `ctrl` register is set to 1 on the same clock cycle as CCS is sampled, the CIU block does not send a CCSD pattern on the CMD line. In this case, the `dto` and `cmd` bits in the `rintsts` register are set to 1.



Due to asynchronous boundaries, the CCS might have already happened and the `send_ccsd` bit is set to 1. In this case, the CCS command does not go to the CE-ATA card device and the `send_ccsd` bit is not set to 0. The host must reset the `send_ccsd` bit to 0 before the next command is issued.

If the send auto stop CCSD (`send_auto_stop_ccsd`) bit in the `ctrl` register is set to 1, the controller sends an internally generated STOP_TRANSMISSION command (CMD12) after sending the CCSD pattern. The controller sets the `acd` bit in the `rintsts` register.

I/O transmission delay (N_{ACIO} Timeout)

The host software maintains the timeout mechanism for handling the I/O transmission delay (N_{ACIO} cycles) time-outs while reading from the CE-ATA card device. The controller neither maintains any timeout mechanism nor indicates that N_{ACIO} cycles are elapsed while waiting for the start bit of a data token. The I/O transmission delay is applicable for read transfers using the `RW_REG` and `RW_BLK` commands; the `RW_REG` and `RW_BLK` commands used in this document refer to the `RW_MULTIPLE_REGISTER` and `RW_MULTIPLE_BLOCK` MMC commands defined by the CE-ATA specification.



After the N_{ACIO} timeout, the application must abort the command by sending the CCSD and STOP commands, or the STOP command. The Data Read Timeout (DRTO) interrupt might be set to 1 while a STOP_TRANSMISSION command is transmitted out of the controller, in which case the data read timeout boot data start bit (`bds`) and the `dto` bit in the `rintsts` register are set to 1.

Data Path

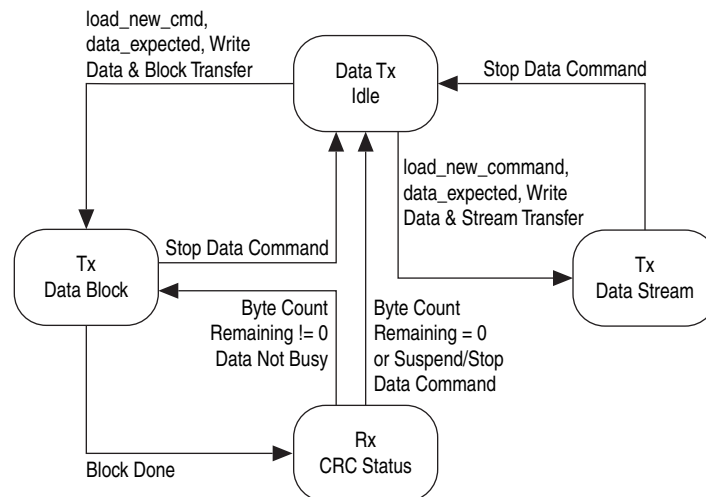
The data path block reads the data FIFO buffer and transmits data on the card bus during a write data transfer, or receives data and writes it to the FIFO buffer during a read data transfer. The data path loads new data parameters—data expected, read/write data transfer, stream/block transfer, block size, byte count, card type, timeout registers—whenever a data transfer command is not in progress. If the data transfer expected bit (`data_expected`) in the `cmd` register is set to 1, the new command is a data transfer command and the data path starts one of the following actions:

- Transmits data if the read/write bit = 1
- Receives data if read/write bit = 0

Data Transmit

The data transmit state machine, illustrated in Figure 11–8, starts data transmission two clock cycles after a response for the data write command is received. This occurs even if the command path detects a response error or response CRC error. If a response is not received from the card because of a response timeout, data is not transmitted. Depending upon the value of the transfer mode bit (`transfer_mode`) in the `cmd` register, the data transmit state machine puts data on the card data bus in a stream or in blocks.

Figure 11–8. Data Transmit State Machine



Stream Data Transmit

If the `transfer_mode` bit in the `cmd` register is set to 1, the transfer is a stream-write data transfer. The data path reads data from the FIFO buffer from the BIU and transmits in a stream to the card data bus. If the FIFO buffer becomes empty, the card clock is stopped and restarted once data is available in the FIFO buffer.

If the `bytcnt` register is reset to 0, the transfer is an open-ended stream-write data transfer. During this data transfer, the data path continuously transmits data in a stream until the host software issues an SD/SDIO STOP command. A stream data transfer is terminated when the end bit of the STOP command and end bit of the data match over two clock cycles.

If the `bytcnt` register is written with a nonzero value and the `send_auto_stop` bit in the `cmd` register is set to 1, the STOP command is internally generated and loaded in the command path when the end bit of the STOP command occurs after the last byte of the stream write transfer matches. This data transfer can also terminate if the host issues a STOP command before all the data bytes are transferred to the card bus.

Single Block Data

If the `transfer_mode` bit in the `cmd` register is set to 0 and the `bytcnt` register value is equal to the value of the `block_size` register, a single-block write-data transfer occurs. The data transmit state machine sends data in a single block, where the number of bytes equals the block size, including the internally-generated 16-term CRC (CRC-16).

If the `ctype` register is set for a 1-bit, 4-bit, or 8-bit data transfer, the data is transmitted on 1, 4, or 8 data lines, respectively, and CRC-16 is separately generated and transmitted for 1, 4, or 8 data lines, respectively.

After a single data block is transmitted, the data transmit state machine receives the CRC status from the card and signals a data transfer to the BIU. This happens when the `dto` bit in the `rintsts` register is set to 1.

If a negative CRC status is received from the card, the data path signals a data CRC error to the BIU by setting the `dcrc` bit in the `rintsts` register.

Additionally, if the start bit of the CRC status is not received by two clock cycles after the end of the data block, a CRC status start-bit error (SBE) is signaled to the BIU by setting the `sbe` bit in the `rintsts` register.

Multiple Block Data

A multiple-block write-data transfer occurs if the `transfer_mode` bit in the `cmd` register is set to 0 and the value in the `bytcnt` register is not equal to the value of the `block_size` register. The data transmit state machine sends data in blocks, where the number of bytes in a block equals the block size, including the internally-generated CRC-16.

If the `ctype` register is set to 1-bit, 4-bit, or 8-bit data transfer, the data is transmitted on 1, 4, or 8 data lines, respectively, and CRC-16 is separately generated and transmitted on 1, 4, or 8 data lines, respectively.

After one data block is transmitted, the data transmit state machine receives the CRC status from the card. If the remaining byte count becomes 0, the data path signals to the BIU that the data transfer is done. This happens when the `dto` bit in the `rintsts` register is set to 1.

If the remaining data bytes are greater than zero, the data path state machine starts to transmit another data block.

If a negative CRC status is received from the card, the data path signals a data CRC error to the BIU by setting the `dcrc` bit in the `rintsts` register, and continues further data transmission until all the bytes are transmitted.

If the CRC status start bit is not received by two clock cycles after the end of a data block, a CRC status SBE is signaled to the BIU by setting the `ebe` bit in the `rintsts` register and further data transfer is terminated.

If the `send_auto_stop` bit is set to 1 in the `cmd` register, the SD/SDIO STOP command is internally generated during the transfer of the last data block, where no extra bytes are transferred to the card. The end bit of the STOP command might not exactly match the end bit of the CRC status in the last data block.

If the block size is less than 4, 16, or 32 for card data widths of 1 bit, 4 bits, or 8 bits, respectively, the data transmit state machine terminates the data transfer when all the data is transferred, at which time the internally-generated STOP command is loaded in the command path.

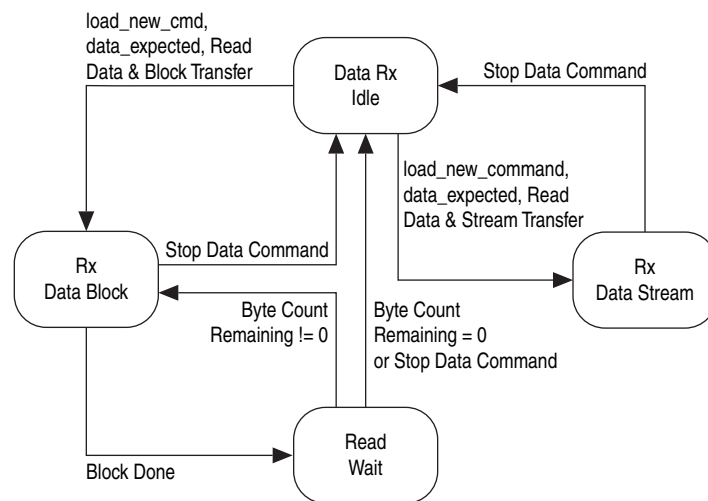
If the `bytcnt` is zero (the block size must be greater than zero) the transfer is an open-ended block transfer. The data transmit state machine for this type of data transfer continues the block-write data transfer until the host software issues an SD/SDIO STOP or STOP_TRANSMISSION (CMD12) command.

Data Receive

The data-receive state machine, illustrated in Figure 11-9, receives data two clock cycles after the end bit of a data read command, even if the command path detects a response error or response CRC error. If a response is not received from the card because a response timeout occurs, the BIU does not receive a signal that the data transfer is complete. This happens if the command sent by the controller is an illegal operation for the card, which keeps the card from starting a read data transfer.

If data is not received before the data timeout, the data path signals a data timeout to the BIU and an end to the data transfer done. Based on the value of the `transfer_mode` bit in the `cmd` register, the data-receive state machine gets data from the card data bus in a stream or block(s).

Figure 11-9. Data Receive State Machine



Stream Data Read

A stream-read data transfer occurs if the `transfer_mode` bit in the `cmd` register is set to 1, at which time the data path receives data from the card and writes it to the FIFO buffer. If the FIFO buffer becomes full, the card clock stops and restarts once the FIFO buffer is no longer full.

An open-ended stream-read data transfer occurs if the `bytcnt` register is set to 0. During this type of data transfer, the data path continuously receives data in a stream until the host software issues an SD/SDIO STOP command. A stream data transfer terminates two clock cycles after the end bit of the STOP command.

If the `bytcnt` register contains a nonzero value and the `send_auto_stop` bit in the `cmd` register is set to 1, a STOP command is internally generated and loaded into the command path, where the end bit of the STOP command occurs after the last byte of the stream data transfer is received. This data transfer can terminate if the host issues an SD/SDIO STOP or STOP_TRANSMISSION (CMD12) command before all the data bytes are received from the card.

Single-block Data Read

If the `ctype` register is set to a 1-bit, 4-bit, or 8-bit data transfer, data is received from 1, 4, or 8 data lines, respectively, and CRC-16 is separately generated and checked for 1, 4, or 8 data lines, respectively. If there is a CRC-16 mismatch, the data path signals a data CRC error to the BIU. If the received end bit is not 1, the BIU receives an End-bit Error (EBE).

Multiple-block Data Read

If the `transfer_mode` bit in the `cmd` register is set to 0 and the value of the `bytcnt` register is not equal to the value of the `block_size` register, the transfer is a multiple-block read-data transfer. The data-receive state machine receives data in blocks, where the number of bytes in a block is equal to the block size, including the internally-generated CRC-16.

If the `ctype` register is set to a 1-bit, 4-bit, or 8-bit data transfer, data is received from 1, 4, or 8 data lines, respectively, and CRC-16 is separately generated and checked for 1, 4, or 8 data lines, respectively. After a data block is received, if the remaining byte count becomes zero, the data path signals a data transfer to the BIU.

If the remaining data bytes are greater than zero, the data path state machine causes another data block to be received. If CRC-16 of a received data block does not match the internally-generated CRC-16, a data CRC error to the BIU and data reception continue further data transmission until all bytes are transmitted. Additionally, if the end of a received data block is not 1, data on the data path signals terminate the bit error to the CIU and the data-receive state machine terminates data reception, waits for data timeout, and signals to the BIU that the data transfer is complete.

If the `send_auto_stop` bit in the `cmd` register is set to 1, the SD/SDIO STOP command is internally generated when the last data block is transferred, where no extra bytes are transferred from the card. The end bit of the STOP command might not exactly match the end bit of the last data block.

If the requested block size for data transfers to cards is less than 4, 16, or 32 bytes for 1-bit, 4-bit, or 8-bit data transfer modes, respectively, the data-transmit state machine terminates the data transfer when all data is transferred, at which point the internally-generated STOP command is loaded in the command path. Data received from the card after that are then ignored by the data path.

If the `bytcnt` register is 0 (the block size must be greater than zero), the transfer is an open-ended block transfer. For this type of data transfer, the data-receive state machine continues the block-read data transfer until the host software issues an SD/SDIO STOP or STOP_TRANSMISSION (CMD12) command.

Auto Stop

The controller internally generates an SD/SDIO STOP command and is loaded in the command path when the `send_auto_stop` bit in the `cmd` register is set to 1. The `AUTO_STOP` command helps to send an exact number of data bytes using a stream read or write for the MMC, and a multiple-block read or write for SD memory transfer for SD cards. The software must set the `send_auto_stop` bit according to details listed in [Table 11-10](#).

Table 11-10. Auto-Stop Generation

ird type	Transfer type	Byte Count	send_auto_stop bit set	Comments
VC	Stream read	0	No	Open-ended stream
VC	Stream read	> 0	Yes	Auto-stop after all bytes transfer
VC	Stream write	0	No	Open-ended stream
VC	Stream write	> 0	Yes	Auto-stop after all bytes transfer
VC	Single-block read	> 0	No	Byte count = 0 is illegal
VC	Single-block write	> 0	No	Byte count = 0 is illegal
VC	Multiple-block read	0	No	Open-ended multiple block
VC	Multiple-block read	> 0	Yes **	Pre-defined multiple block
VC	Multiple-block write	0	No	Open-ended multiple block
VC	Multiple-block write	> 0	Yes **	Pre-defined multiple block
MEM	Single-block read	> 0	No	Byte count = 0 is illegal
MEM	Single-block write	> 0	No	Byte count = 0 illegal
MEM	Multiple-block read	0	No	Open-ended multiple block
MEM	Multiple-block read	> 0	Yes	Auto-stop after all bytes transfer
MEM	Multiple-block write	0	No	Open-ended multiple block
MEM	Multiple-block write	> 0	Yes	Auto-stop after all bytes transfer
SDIO	Single-block read	> 0	No	Byte count = 0 is illegal
SDIO	Single-block write	> 0	No	Byte count = 0 illegal
SDIO	Multiple-block read	0	No	Open-ended multiple block
SDIO	Multiple-block read	> 0	No	Pre-defined multiple block
SDIO	Multiple-block write	0	No	Open-ended multiple block
SDIO	Multiple-block write	> 0	No	Per-defined multiple block

** The condition under which the transfer mode is set to block transfer and *byte_count* is equal to block size is treated as a single-block data transfer command for both MMC and SD cards. If *byte_count* = *n* * *block_size* (*n* = 2, 3, ...), the condition is treated as a predefined multiple-block data transfer command. In the case of an MMC card, the host software can perform a predefined data transfer in two ways: 1) Issue the CMD23 command before issuing CMD18/CMD25 commands to the card – in this case, issue CMD18/CMD25 commands without setting the *send_auto_stop* bit. 2) Issue CMD18/CMD25 commands without issuing CMD23 command to the card, with the *send_auto_stop* bit set. In this case, the multiple-block data transfer is terminated by an internally-generated auto-stop command after the programmed byte count.

The following list describes conditions for the AUTO_STOP command:

- Stream-read for MMC with byte count greater than zero—The controller generates an internal STOP command and loads it into the command path so that the end bit of the STOP command is sent when the last byte of data is read from the card and no extra data byte is received. If the byte count is less than six (48 bits), a few extra data bytes are received from the card before the end bit of the STOP command is sent.
- Stream-write for MMC with byte count greater than zero—The controller generates an internal STOP command and loads it into the command path so that the end bit of the STOP command is sent when the last byte of data is transmitted on the card bus and no extra data byte is transmitted. If the byte count is less than six (48 bits), the data path transmits the data last to meet these condition.
- Multiple-block read memory for SD card with byte count greater than zero—If the block size is less than four (single-bit data bus), 16 (4-bit data bus), or 32 (8-bit data bus), the AUTO_STOP command is loaded in the command path after all the bytes are read. Otherwise, the STOP command is loaded in the command path so that the end bit of the STOP command is sent after the last data block is received.
- Multiple-block write memory for SD card with byte count greater than zero—If the block size is less than three (single-bit data bus), 12 (4-bit data bus), or 24 (8-bit data bus), the AUTO_STOP command is loaded in the command path after all data blocks are transmitted. Otherwise, the STOP command is loaded in the command path so that the end bit of the STOP command is sent after the end bit of the CRC status is received.
- Precaution for host software during auto-stop—When an AUTO_STOP command is issued, the host software must not issue a new command to the controller until the AUTO_STOP command is sent by the controller and the data transfer is complete. If the host issues a new command during a data transfer with the AUTO_STOP command in progress, an AUTO_STOP command might be sent after the new command is sent and its response is received. This can delay sending the STOP command, which transfers extra data bytes. For a stream write, extra data bytes are erroneous data that can corrupt the card data. If the host wants to terminate the data transfer before the data transfer is complete, it can issue an SD/SDIO STOP or STOP_TRANSMISSION (CMD12) command, in which case the controller does not generate an AUTO_STOP command.

Non-Data Transfer Commands that Use Data Path

Some SD/SDIO non-data transfer commands (commands other than read and write commands) also use the data path. Table 11-11 lists the commands and their register setup requirements.

Table 11-11. Non-Data Transfer Commands and Requirements

	PROGRAM_CSD (CMD27)	SEND_WRITE_PROT (CMD30)	LOCK_UNLOCK (CMD42)	SD_STATUS (ACMD13)	SEND_NUM_WR_BLOCKS (ACMD22)	SEND_SCR (ACMD51)
cmd Register Setup						
Cmd_index	0x1B=27	0x1E=30	0x2A=42	0x0D=13	0x16=22	0x33=51
Response_expect	1	1	1	1	1	1
Response_length	0	0	0	0	0	0
Check_response_crc	1	1	1	1	1	1
Data_expected	1	1	1	1	1	1
Read/write	1	0	1	0	0	0
Transfer_mode	0	0	0	0	0	0
Send_auto_stop	0	0	0	0	0	0
Wait_prevdata_complete	0	0	0	0	0	0
Stop_abort_cmd	0	0	0	0	0	0
cmdarg Register Setup						
	Stuff bits	32-bit write protect data address	Stuff bits	Stuff bits	Stuff bits	Stuff bits
blksiz Register Setup						
	16	4	Num_bytes ⁽¹⁾	64	4	8
bytcnt Register Setup						
	16	4	Num_bytes ⁽¹⁾	64	4	8

Note to Table 11-11:

- (1) Num_bytes = Number of bytes specified as per the lock card data structure. Refer to the SD specification and the MMC specification.

Table 11-12.

	CMD27	CMD30	CMD42	ACMD13	ACMD22	ACMD51
Command register programming						
Cmd_index	6'h1B	6'h1E	6'h2A	6'h0D	6'h16	6'h33
Response_expect	1	1	1	1	1	1
Response_length	0	0	0	0	0	0
Check_response_crc	1	1	1	1	1	1
Data_expected	1	1	1	1	1	1
Read/write	1	0	1	0	0	0
Transfer_mode	0	0	0	0	0	0
Send_auto_stop	0	0	0	0	0	0
Wait_prevdata_complete	0	0	0	0	0	0
Stop_abort_cmd	0	0	0	0	0	0
Command Argument register programming						
	Stuff bits	32-bit write protect data address	Stuff bits	Stuff bits	Stuff bits	Stuff bits
Block Size register programming						
	16	4	Num_bytes*	64	4	8
Byte Count register programming						
	16	4	Num_bytes*	64	4	8
*: Num_bytes = No. of bytes specified as per the lock card data structure (Refer to the SD specification and the MMC specification).						

Clock Control Block

The clock control block provides different clock frequencies required for SD/MMC/CE-ATA cards. The clock control block has one clock divider, which is used to generate different card clock frequencies.

The clock frequency of a card depends on the following clock ctrl register settings:

- **clkdiv register**—Internal clock dividers are used to generate different clock frequencies required for the cards. The division factor for the clock divider can be set by writing to the clkdiv register. The clock divider is an 8-bit value that provides a clock division factor from 1 to 510; a value of 0 represents a clock-divider bypass, a value of 1 represents a divide by 2, a value of 2 represents a divide by 4, and so on.
- **clksrc register**—Set this register to 0 as clock is divided by clock divider 0.

- **clkena register**—The `cclk_out` card output clock can be enabled or disabled under the following conditions:
 - `cclk_out` is enabled when the `cclk_enable` bit in the `clkena` register is set to 1 and disabled when set to 0.
 - Low-power mode can be enabled by setting the `cclk_low_power` bit of the `clkena` register to 1. If low-power mode is enabled to save card power, the `cclk_out` signal is disabled when the card is idle for at least eight card clock cycles. Low-power mode is enabled when a new command is loaded and the command path goes to a non-idle state.

Under the following conditions, the card clock is stopped or disabled:

- Clock can be disabled by writing to the `clkena` register.
- When low-power mode is selected and the card is idle for at least eight clock cycles.
- FIFO buffer is full, data path cannot accept more data from the card, and data transfer is incomplete—to avoid FIFO buffer overflow.
- FIFO buffer is empty, data path cannot transmit more data to the card, and data transfer is incomplete—to avoid FIFO buffer underflow.



The card clock must be disabled through the `clkena` register before the host software changes the values of the `clkdiv` and `clksrc` registers.

Error Detection

Errors can occur during card operations within the CIU in the following situations.

Response

- Response timeout—did not receive the response expected with response start bit within the specified number of clock cycles in the timeout register.
- Response CRC error—response is expected and check response CRC requested; response CRC-7 does not match with the internally-generated CRC-7.
- Response error—response transmission bit is not 0, command index does not match with the command index of the send command, or response end bit is not 1.

Data Transmit

- No CRC status—during a write data transfer, if the CRC status start bit is not received for two clock cycles after the end bit of the data block is sent out, the data path performs the following actions:
 - Signals no CRC status error to the BIU
 - Terminates further data transfer
 - Signals data transfer done to the BIU

- Negative CRC—if the CRC status received after the write data block is negative (that is, not 0b010), the data path signals a data CRC error to the BIU and continues with the data transfer.
- Data starvation due to empty FIFO buffer—if the FIFO buffer becomes empty during a write data transmission, or if the card clock stopped and the FIFO buffer remains empty for a data-timeout number of clock cycles, the data path signals a data-starvation error to the BIU and the data path continues to wait for data in the FIFO buffer.

Data Receive

- Data timeout—during a read-data transfer, if the data start bit is not received before the number of clock cycles specified in the timeout register, the data path does the following action:
 - Signals a data-timeout error to the BIU
 - Terminates further data transfer
 - Signals data transfer done to BIU
- Data SBE—during a 4-bit or 8-bit read-data transfer, if the all-bit data line does not have a start bit, the data path signals a data SBE to the BIU and waits for a data timeout, after which it signals that the data transfer is done.
- Data CRC error—during a read-data-block transfer, if the CRC-16 received does not match with the internally generated CRC-16, the data path signals a data CRC error to the BIU and continues with the data transfer.
- Data EBE—during a read-data transfer, if the end bit of the received data is not 1, the data path signals an EBE to the BIU, terminates further data transfer, and signals to the BIU that the data transfer is done.
- Data starvation due to FIFO buffer full—during a read data transmission and when the FIFO buffer becomes full, the card clock stops. If the FIFO buffer remains full for a data-timeout number of clock cycles, the data path signals a data starvation error to the BIU, by setting the data starvation host timeout bit (hto) in rintsts register to 1, and the data path continues to wait for the FIFO buffer to empty.

Clocks

The SD/MMC controller clocks are listed in [Table 11-13](#).

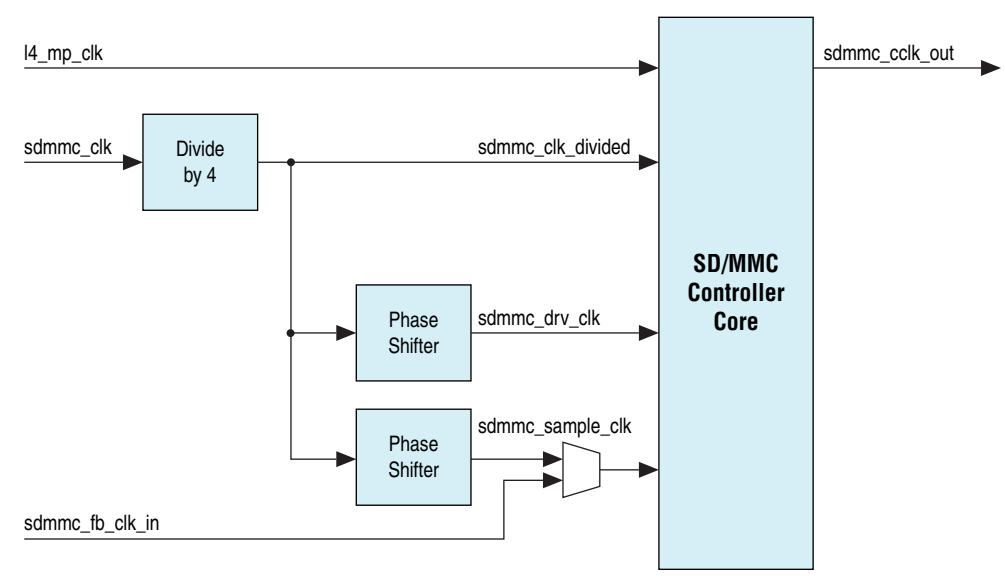
Table 11-13. SD/MMC Controller Clocks (Part 1 of 2)

Clock Name	Direction	Description
sdmmc_clk	In	Clock for SD/MMC controller CIU
l4_mp_clk	In	Clock for SD/MMC controller BIU
sdmmc_cclk_out	Out	Generated output clock for card
sdmmc_sample_clk	Internal	Phase-shifted clock of sdmmc_clk used to sample the command and data from the card

Table 11-13. SD/MMC Controller Clocks (Part 2 of 2)

Clock Name	Direction	Description
sdmmc_drv_clk	Internal	Phase-shifted clock of sdmmc_clk for controller to drive command and data to the card to meet hold time requirements
sdmmc_clk_divided	Internal	Divide-by-four clock of sdmmc_clk

Figure 11-10 shows the connection of various clocks to the controller.

Figure 11-10. SD/MMC Controller Clock Connections

The sdmmc_clk clock from the clock manager is divided by four (sdmmc_clk_divided clock) before passed to the phase shifters and controller. The phase shifters are used to generate the sdmmc_drv_clk and sdmmc_sample_clk clocks. These phase shifters provide up to eight phases shift which include 0, 45, 90, 135, 180, 225, 270, and 315 degrees. The sdmmc_sample_clk clock can be driven by the output from the phase shifter. The selections of phase shift degree and sdmmc_sample_clk source are done in the system manager. For information about setting the phase shift and selecting the source of the sdmmc_sample_clk clock, refer to “Clock Setup” on page 11-40.

The controller generates the sdmmc_cclk_out clock, which is driven to the card. For more information about the generation of the sdmmc_cclk_out clock, refer to “Clock Control Block” on page 11-31.

Resets

The SD/MMC controller has one reset signal. The reset manager drives this signal to the SD/MMC controller on a cold or warm reset.



For more information, refer to the *Reset Manager* chapter in volume 3 of the *Cyclone V Device Handbook*.

Interface Signals

Table 11-14 lists I/O pin use of the SD/MMC controller interface signals.

Table 11-14. SD/MMC Controller Interface I/O Pins

Signal	Width	Direction	Description
sdmmc_cclk_out	1	Out	Clock from controller to the card
sdmmc_cmd	1	In/Out	Card command
sdmmc_pwren	1	Out	External device power enable
sdmmc_data	8	In/Out	Card data

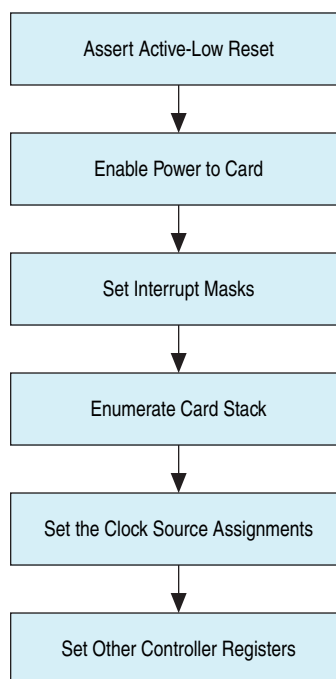
SD/MMC Controller Programming Model

Initialization

This section describes how to initialize the SD/MMC controller.

Figure 11-11 shows the initialization flow of the SD/MMC controller. After the power and clock to the controller are stable, the controller active-low reset is asserted. The reset sequence initializes the registers, FIFO buffer pointers, DMA interface controls, and state machines in the controller.

Figure 11-11. SD/MMC Controller Initialization Sequence



Software must perform the following steps after the power-on-reset:

1. Before enabling power to the card, confirm that the voltage setting to the voltage regulator is correct.
2. Enable power to the card by setting the power enable bit (`power_enable`) in the power enable register (`pwren`) to 1. Wait for the power ramp-up time before proceeding to the next step.
3. Set the interrupt masks by resetting the appropriate bits to 0 in the `intmask` register.
4. Set the `int_enable` bit of the `ctrl` register to 1.



Altera recommends that you write 0xFFFFFFFF to the `rintsts` register to clear any pending interrupts before setting the `int_enable` bit to 1.

5. Discover the card stack according to the card type. For discovery, you must restrict the clock frequency to 400 kHz in accordance with SD/MMC/CE-ATA standards. For more information, refer to “Enumerated Card Stack” on page 11-37.
6. Set the clock source assignments. Set the card frequency using the `clkdiv` and `clksrc` registers of the controller. For more information, refer to “Clock Setup” on page 11-40.
7. The following common registers and fields can be set during initialization process:
 - The response timeout field (`response_timeout`) of the `tmout` register. A typical value is 0x64.
 - The data timeout field (`data_timeout`) of the `tmout` register, highest of the following:
 - $10 * N_{AC}$
 - $10 * ((TAAC * F_{OP}) + (100 * NSAC))$
 where:
 N_{AC} = card device total access time
 $TAAC$ = Time-dependent factor of the data access time

F_{OP} = The card clock frequency used for the card operation

NSAC = Worst-case clock rate-dependent factor of the data access time

- Host FIFO buffer latency

On read: Time elapsed before host starts reading from a full FIFO buffer

On write: Time elapsed before host starts writing to an empty FIFO buffer

- Debounce counter register (debncn). A typical debounce value is 25 ms.
- TX watermark field (tx_wmark) of the FIFO threshold watermark register (fifoth). Typically, the threshold value is set to 512, which is half the FIFO buffer depth.
- RX watermark field (rx_wmark) of the fifoth register. Typically, the threshold value is set to 511.

These registers do not need to be changed with every SD/MMC/CE-ATA command. Set them to a typical value according to the SD/MMC/CE-ATA specifications.


Enumerated Card Stack

The card stack performs the following tasks:

- Discovers the connected card
- Sets the relative Card Address Register (RCA) in the connected card
- Reads the card specific information
- Stores the card specific information locally

The card connected to the controller can be an MMC, CE-ATA, SD or SDIO (including IO ONLY, MEM ONLY and COMBO) card. To identify the connected card type, the following discovery sequence is needed:

1. Reset the card width 1 or 4 bit (card_width2) and card width 8 bit (card_width1) fields in the ctype register to 0.
2. Identify the card type as SD, MMC, SDIO or SDIO-COMBO:
 - a. Send an SD/SDIO IO_SEND_OP_COND (CMD5) command with argument 0 to the card.
 - b. Read resp0 on the controller. The response to the IO_SEND_OP_COND command gives the voltage that the card supports.
 - c. Send the IO_SEND_OP_COND command, with the desired voltage window in the arguments. This command sets the voltage window and makes the card exit the initialization state.
 - d. Check bit 27 in resp0.
 - If bit 27 is 0, the SDIO card is IO ONLY. In this case, proceed to step 5.
 - If bit 27 is 1, the card type is SDIO COMBO. Continue with the following steps.

3. Only continue with this step if the SDIO card type is COMBO or there is no response received from the previous IO_SEND_OP_COND command. Otherwise, skip to step 5.
 - a. Send the SD/SDIO SEND_IF_COND (CMD8) command with the following arguments:
 - Bit[31:12] = 0x0 (reserved bits)
 - Bit[11:8] = 0x1 (supply voltage value)
 - Bit[7:0] = 0xAA (preferred check pattern by SD memory cards compliant with *SDIO Simplified Specification Version 2.00* and later.)
 -  Refer to *SDIO Simplified Specification Version 2.00* as described in “References” on page 11-79:
 - b. If a response is received to the previous SEND_IF_COND command, the card supports SD High-Capacity, compliant with *SD Specifications, Part 1, Physical Layer Simplified Specification Version 2.00*.
If no response is received, proceed to step e.
 - c. Send the SD_SEND_OP_COND (ACMD41) command with the following arguments:
 - Bit[31] = 0x0 (reserved bits)
 - Bit[30] = 0x1 (high capacity status)
 - Bit[29:25] = 0x0 (reserved bits)
 - Bit[24] = 0x1 (S18R --supports voltage switching for 1.8V)
 - Bit[23:0] = supported voltage range
 - d. If a response is received to the previous SD_SEND_OP_COND command, the card type is SDHC. Otherwise, the card is MMC or CE-ATA. In either case, skip the following steps and proceed to step 5.
 - e. If a response is not received to the initial SEND_IF_COND command, the card does not support High Capacity SD2.0. Next, issue the GO_IDLE_STATE command followed by the SD_SEND_OP_COND command with the following arguments:
 - Bit[31] = 0x0 (reserved bits)
 - Bit[30] = 0x0 (high capacity status)
 - Bit[29:24] = 0x0 (reserved bits)
 - Bit[23:0] = supported voltage range
 - f. If a response is received to the previous SD_SEND_OP_COND command, the card is SD type. Otherwise, the card is MMC or CE-ATA.



You must issue the SEND_IF_COND command prior to the first SD_SEND_OP_COND command, to initialize the High Capacity SD memory card. The card returns busy as a response to the SD_SEND_OP_COND command when any of the following conditions are true:

- The card executes its internal initialization process.
 - A SEND_IF_COND command is not issued before the SD_SEND_OP_COND command.
 - The ACMD41 command is issued. In the command argument, the Host Capacity Support (HCS) bit is set to 0, for a high capacity SD card.
4. Use the following sequence to determine whether the card is a CE-ATA 1.1, CE-ATA 1.0, or MMC device:
- a. Determine whether the card is a CE-ATA v1.1 card device by attempting to select ATA mode. Send the SD/SDIO SEND_IF_COND command, querying byte 504 (S_CMD_SET) of the EXT_CSD register block in the external card.
- If bit 4 is set to 1, the card device supports ATA mode. Send the SWITCH_FUNC (CMD6) command, setting the ATA bit (bit 4) of the EXT_CSD register slice 191 (CMD_SET) to 1. This command selects ATA mode and activates the ATA command set.

You can verify the currently selected mode by reading it back from byte 191 of the EXT_CSD register.

Skip to step 5.

- If the card device does not support ATA mode, it might be an MMC card or a CE-ATA v1.0 card. Continue to Step b.
- b. Determine whether the card is a CE-ATA 1.0 card device or an MMC card device by sending the RW_REG command. If a response is received and the response data contains the CE-ATA signature, the card is a CE-ATA 1.0 card device. Otherwise, the card is an MMC card device.
5. At this point, the software has determined the card type as SD/SDHC, SDIO or SDIO-COMBO. Now it must enumerate the card stack according to the type that has been discovered.

6. Set the card clock source frequency to the frequency of identification clock rate, 400 KHz. Use one of the following discovery command sequences:
 - For an SD card or an SDIO memory section, send the following SD/SDIO command sequence:
 - GO_IDLE_STATE
 - SEND_IF_COND
 - SD_SEND_OP_COND (ACMD41)
 - ALL_SEND_CID (CMD2)
 - SEND_RELATIVE_ADDR (CMD3)
 - For an SDIO card, send the following command sequence:
 - IO_SEND_OP_COND.
 - If the function count is valid, send the SEND_RELATIVE_ADDR command.
 - For an MMC, send the following command sequence:
 - GO_IDLE_STATE
 - SEND_OP_COND (CMD1)
 - ALL_SEND_CID
 - SEND_RELATIVE_ADDR
7. You can change the card clock frequency after discovery by writing a value to the `clkdiv` register that divides down the `sdmmc_clk` clock.
The following list shows typical clock frequencies for various types of cards:
 - SD memory card, 25 MHz
 - MMC card device, 12.5 MHz
 - Full speed SDIO, 25 MHz
 - Low speed SDIO, 400 kHz

Clock Setup

The following registers of the SD/MMC controller allow software to select the desired clock frequency for the card:

- `clksrc`
- `clkdiv`
- `clkena`

The controller loads these registers when it receives an update clocks command, as described in this section. To change the card clock frequency, perform the following steps:

1. Before disabling the clocks, ensure that the card is not busy with any previous data command. To do so, verify that the `data_busy` bit of the status register (`status`) is 0.
2. Reset the `cclk_enable` bit of the `clkena` register to 0, to disable the card clock generation.

3. Reset the `clksrc` register to 0.
4. Set the following bits in the `cmd` register to 1:
 - `update_clk_regs_only`—Specifies the update clocks command
 - `wait_prvdata_complete`—Ensures that clock parameters do not change until any ongoing data transfer is complete
 - `start_cmd`—Initiates the command
5. Wait until the `start_cmd` and `update_clk_regs_only` bits change to 0. There is no interrupt when the clock modification completes. The controller does not set the `command_done` bit in the `rintsts` register upon command completion. The controller might signal a hardware lock error if it already has another command in the queue. In this case, return to Step 4.

For information about hardware lock errors, refer to “[Interrupt and Error Handling](#)” on page 11-66.

6. Reset the `sdmmc_clk_enable` bit to 0 in the enable register of the clock manager peripheral PLL group (`perpllgrp`).
7. In the control register (`ctrl`) of the SDMMC controller group (`sdmmcgrp`) in the system manager, set the drive clock phase shift select (`drvsel`) and sample clock phase shift select (`smp1sel`) bits to specify the required phase shift value.
8. Set the `sdmmc_clk_enable` bit in the Enable register of the clock manager `perpllgrp` group to 1.
9. Set the `clkdiv` register of the controller to the correct divider value for the required clock frequency.
10. Set the `cclk_enable` bit of the `clkena` register to 1, to enable the card clock generation.

You can also use the `clkena` register to enable low-power mode, which automatically stops the `sdmmc_cclk_out` clock when the card is idle for more than eight clock cycles.

Controller/DMA/FIFO Buffer Reset Usage

The following list shows the effect of reset on various parts in the SD/MMC controller:

- **Controller reset**—resets the controller by setting the `controller_reset` bit in the `ctrl` register to 1. Controller reset resets the CIU and state machines, and also resets the BIU-to-CIU interface. Because this reset bit is self-clearing, after issuing the reset, wait until this bit changes to 0.
- **FIFO buffer reset**—resets the FIFO buffer by setting the FIFO reset bit (`fifo_reset`) in the `ctrl` register to 1. FIFO buffer reset resets the FIFO buffer pointers and counters in the FIFO buffer. Because this reset bit is self-clearing, after issuing the reset, wait until this bit changes to 0.

- **DMA reset**—resets the internal DMA controller logic by setting the DMA reset bit (`dma_reset`) in the `ctrl` register to 1, which immediately terminates any DMA transfer in progress. Because this reset bit is self-clearing, after issuing the reset, wait until this bit changes to 0.



Ensure that the DMA is idle before performing a DMA reset. Otherwise, the L3 interconnect might be left in an indeterminate state.

Altera recommends setting the `controller_reset`, `fifo_reset`, and `dma_reset` bits in the `ctrl` register to 1 first, and then resetting the `rintsts` register to 0 using another write, to clear any resultant interrupt.

Enabling FIFO Buffer ECC

To protect the FIFO buffer data with ECC, you must enable the ECC feature before performing any operations with the SD/MMC controller. Perform the following steps to enable the FIFO buffer ECC feature:

1. Verify there are no commands committed to the controller.
2. Ensure that the FIFO buffer is initialized. Initialize the FIFO buffer by writing 0 to all 1024 FIFO buffer locations. A FIFO buffer write to any address from 0x200 to the maximum FIFO buffer size is valid.
3. Set the SDMMC RAM ECC single and double, correctable error interrupt status bits (`serrporta`, `derrporta`, `serrportb`, and `derrportb`) to 1 in the `sdmmc` register in the `eccgrp` group of the system manager, to clear any previously-detected ECC errors.
4. Reset the FIFO buffer by setting the `fifo_reset` bit to 1 in the `ctrl` register. This action resets pointers and counters in the FIFO buffer. This reset bit is self-clearing, so after issuing the reset, wait until the bit changes to 0.
5. Set the `en` bit in `sdmmc` register in `eccgrp` group of the system manager to 1, to enable ECC for the FIFO buffer in SD/MMC controller.

Non-Data Transfer Commands

To send any non-data transfer command, the software needs to write the `cmd` register and the `cmdarg` register with appropriate parameters. Using these two registers, the controller forms the command and sends it to the `CMD` pin. The controller reports errors in the command response through the error bits of the `rintsts` register.

When a response is received—either erroneous or valid—the controller sets the `command_done` bit in the `rintsts` register to 1. A short response is copied to `resp0`, while a long response is copied to all four response registers (`resp0`, `resp1`, `resp2`, and `resp3`). For long responses, bit 31 of `resp3` represents the MSB and bit 0 of `resp0` represents the LSB.

For basic and non-data transfer commands, perform the following steps:

1. Write the `cmdarg` register with the appropriate command argument parameter.
2. Write the `cmd` register with the settings in [Table 11-15 on page 11-44](#).

3. Wait for the controller to accept the command. The `start_cmd` bit changes to 0 when the command is accepted.

The following actions occur when the command is loaded into the controller:

- If no previous command is being processed, the controller accepts the command for execution and resets the `start_cmd` bit in the `cmd` register to 0. If a previous command is being processed, the controller loads the new command in the command buffer.
 - If the controller is unable to load the new command—that is, a command is already in progress, a second command is in the buffer, and a third command is attempted—the controller generates a hardware lock error.
4. Check if there is a hardware lock error.
 5. Wait for command execution to complete. After receiving either a response from a card or response timeout, the controller sets the `command_done` bit in the `rintsts` register to 1. Software can either poll for this bit or respond to a generated interrupt (if enabled).
 6. Check if the response timeout boot acknowledge received (`bar`), `rcrc`, or `re` bit is set to 1. Software can either respond to an interrupt raised by these errors or poll the `re`, `rcrc`, and `bar` bits of the `rintsts` register. If no response error is received, the response is valid. If required, software can copy the response from the response registers.



Software cannot modify clock parameters while a command is being executed.

Table 11-15. cmd Register Settings for Non-Data Transfer Command

Parameter	Value	Comment
Default		
start_cmd	1	This bit resets itself to 0 after the command is committed.
use_hold_reg	1 or 0	Choose the value based on the speed mode being used.
update_clk_regs_only	0	Indicates that the command is not a clock update command
data_expected	0	Indicates that the command is not a data command
card_number	1	For one card
cmd_index	Command Index	Set this parameter to the command number. For example, set to 8 for the SD/SDIO SEND_IF_COND (CMD8) command.
send_initialization	0 or 1	1 for card reset commands such as the SD/SDIO GO_IDLE_STATE command 0 otherwise
stop_abort_cmd	0 or 1	1 for a command to stop data transfer, such as the SD/SDIO STOP_TRANSMISSION command 0 otherwise
response_length	0 or 1	1 for R2 (long) response 0 for short response
response_expect	0 or 1	0 for commands with no response, such as SD/SDIO GO_IDLE_STATE, SET_DSR (CMD4), or GO_INACTIVE_STATE (CMD15). 1 otherwise
User-Selectable		
wait_prvdata_complete	1	Before sending a command on the command line, the host must wait for completion of any data command already in process. Altera recommends that you set this bit to 1, unless the current command is to query status or stop data transfer when transfer is in progress.
check_response_crc	1 or 0	1 if the response includes a valid CRC, and the software is required to crosscheck the response CRC bits. 0 otherwise

Data Transfer Commands

Data transfer commands transfer data between the memory card and the controller. To issue a data command, the controller requires a command argument, total data size, and block size. Data transferred to or from the memory card is buffered by the controller FIFO buffer.

Before issuing a data transfer command, software must confirm that the card is not busy and is in a transfer state, by performing the following steps:

1. Issue an SD/SDIO SEND_STATUS (CMD13) command. The controller sends the status of the card as the response to the command.
2. Check the card's busy status.

3. Wait until the card is not busy.
4. Check the card's transfer status. If the card is in the stand-by state, issue an SD/SDIO SELECT/DESELECT_CARD (CMD7) command to place it in the transfer state.



During CE-ATA RW_BLK write transfers, the MMC busy signal might be asserted after the last block. If the CE-ATA card device interrupt is disabled (the `nIEN` bit in the card device's ATA control register is set to 1), the `dto` bit in the `rintsts` register is set to 1 even though the card sends MMC BUSY. The host cannot issue the CMD60 command to check the ATA busy status after a CMD61 command. Instead, the host must perform one of the following actions:

- Issue the SEND_STATUS command and check the MMC busy status before issuing a new CMD60 command
- Issue the CMD39 command and check the ATA busy status before issuing a new CMD60 command

For the data transfer commands, software must set the `ctype` register to the bus width that is programmed in the card.

The controller generates an interrupt for different conditions during data transfer, which are reflected in the following `rintsts` register bits:

1. `dto`—Data transfer is over or terminated. If there is a response timeout error, the controller does not attempt any data transfer and the Data Transfer Over bit is never set.
2. Transmit FIFO data request bit (`txdr`)—The FIFO buffer threshold for transmitting data is reached; software is expected to write data, if available, into the FIFO buffer.
3. Receive FIFO data request bit (`rxdr`)—The FIFO buffer threshold for receiving data is reached; software is expected to read data from the FIFO buffer.
4. `hto`—The FIFO buffer is empty during transmission or is full during reception. Unless software corrects this condition by writing data for empty condition, or reading data for full condition, the controller cannot continue with data transfer. The clock to the card is stopped.
5. `bds`—The card has not sent data within the timeout period.
6. `dcrc`—A CRC error occurred during data reception.
7. `sbe`—The start bit is not received during data reception.
8. `ebe`—The end bit is not received during data reception, or for a write operation. A CRC error is indicated by the card.

Conditions 6, 7, and 8 indicate that the received data might have errors. If there is a response timeout, no data transfer occurs.

Single-Block or Multiple-Block Read

To implement a single-block or multiple-block read, the software performs the following steps:

1. Write the data size in bytes to the `bytcnt` register. For a multi-block read, `bytcnt` must be a multiple of the block size.
2. Write the block size in bytes to the `blksiz` register. The controller expects data to return from the card in blocks of size `blksiz`.
3. If the read round trip delay, including the card delay, is greater than half of `sdmmc_clk_divided`, write to the card threshold control register (`cardthrcctl`) to ensure that the card clock does not stop in the middle of a block of data being transferred from the card to the host. For more information, refer to “[Card Read Threshold](#)” on page 11-64.



If the card read threshold enable bit (`cardrdthren`) is 0, the host system must ensure that the RX FIFO buffer does not become full during a read data transfer by ensuring that the RX FIFO buffer is read at a rate faster than that at which data is written into the FIFO buffer. Otherwise, an overflow might occur.

4. Write the `cmdarg` register with the beginning data address for the data read.
5. Write the `cmd` register with the parameters listed in [Table 11-16](#). For SD and MMC cards, use the SD/SDIO READ_SINGLE_BLOCK (CMD17) command for a single-block read and the READ_MULTIPLE_BLOCK (CMD18) command for a multiple-block read. For SDIO cards, use the IO_RW_EXTENDED (CMD53) command for both single-block and multiple-block transfers. After writing to the `cmd` register, the controller starts executing the command. When the command is sent to the bus, the Command Done interrupt is generated.
6. Software must check for data error interrupts, reported in the `dcrc`, `bds`, `sbe`, and `ebe` bits of the `rintsts` register. If required, software can terminate the data transfer by sending an SD/SDIO STOP command.

7. Software must check for host timeout conditions in the `rintsts` register:
 - Receive FIFO buffer data request
 - Data starvation from host—the host is not reading from the FIFO buffer fast enough to keep up with data from the card. To correct this condition, software must perform the following steps:
 - Read the `fifo_count` field of the `status` register
 - Read the corresponding amount of data out of the FIFO buffer

In both cases, the software must read data from the FIFO buffer and make space in the FIFO buffer for receiving more data.
8. When a DTO interrupt is received, the software must read the remaining data from the FIFO buffer.

Table 11-16. cmd Register Settings for Single-Block and Multiple-Block Reads

Parameter	Value	Comment
Default		
<code>start_cmd</code>	1	This bit resets itself to 0 after the command is committed.
<code>use_hold_reg</code>	1 or 0	Choose the value based on speed mode being used.
<code>update_clk_regs_only</code>	0	Does not need to update clock parameters
<code>data_expected</code>	1	Data command
<code>card_number</code>	1	For one card
<code>transfer_mode</code>	0	Block transfer
<code>send_initialization</code>	0	1 for a card reset command such as the SD/SDIO <code>GO_IDLE_STATE</code> command 0 otherwise
<code>stop_abort_cmd</code>	0	1 for a command to stop data transfer such as the SD/SDIO <code>STOP_TRANSMISSION</code> command 0 otherwise
<code>send_auto_stop</code>	0 or 1	Set according to Table 11-10 on page 11-28
<code>read_write</code>	0	Read from card
<code>response_length</code>	0	1 for R2 (long) response 0 for short response
<code>response_expect</code>	1 or 0	0 for commands with no response, such as SD/SDIO <code>GO_IDLE_STATE</code> , <code>SET_DSR</code> , and <code>GO_INACTIVE_STATE</code> . 1 otherwise
User-Selectable		
<code>wait_prvdata_complete</code>	1 or 0	0—sends command to CIU immediately 1—sends command after previous data transfer ends
<code>check_response_crc</code>	1 or 0	0—Controller must not check response CRC 1—Controller must check response CRC
<code>cmd_index</code>	Command Index	Set this parameter to the command number. For example, set to 17 or 18 for SD/SDIO <code>READ_SINGLE_BLOCK</code> (CMS17) or <code>READ_MULTIPLE_BLOCK</code> (CMD18).

Single-Block or Multiple-Block Write

The following steps comprise a single-block or multiple-block write:

1. Write the data size in bytes to the `bytcnt` register. For a multi-block write, `bytcnt` must be a multiple of the block size.
2. Write the block size in bytes to the `blksiz` register. The controller sends data in blocks of size `blksiz` each.
3. Write the `cmdarg` register with the data address to which data must be written.
4. Write data into the FIFO buffer. For best performance, the host software should write data continuously until the FIFO buffer is full.
5. Write the `cmd` register with the parameters listed in [Table 11-17 on page 11-49](#). For SD and MMC cards, use the SD/SDIO `WRITE_BLOCK` (CMD24) command for a single-block write and the `WRITE_MULTIPLE_BLOCK` (CMD25) command for a multiple-block writes. For SDIO cards, use the `IO_RW_EXTENDED` command for both single-block and multiple-block transfers.

After writing to the `cmd` register, the controller starts executing a command if there is no other command already being processed. When the command is sent to the bus, a Command Done interrupt is generated.

6. Software must check for data error interrupts; that is, for `dcrc`, `bds`, and `ebe` bits of the `rintsts` register. If required, software can terminate the data transfer early by sending the SD/SDIO `STOP` command.

7. Software must check for host timeout conditions in the `rintsts` register:

- Transmit FIFO buffer data request
- Data starvation by the host—the controller wrote data to the card faster than the host could supply the data.

In both cases, the software must write data into the FIFO buffer.

There are two types of transfers: open-ended and fixed length.

- Open-ended transfers—For an open-ended block transfer, the byte count is 0. At the end of the data transfer, software must send the `STOP_TRANSMISSION` command (CMD12).
- Fixed-length transfers—The byte count is nonzero. You must already have written the number of bytes to the `bytcnt` register. The controller issues the `STOP` command for you if you set the `send_auto_stop` bit of the `cmd` register to 1. After completion of a transfer of a given number of bytes, the controller sends the `STOP` command. Completion of the `AUTO_STOP` command is reflected by the `Auto Command Done` interrupt. A response to the `AUTO_STOP` command is written to the `resp1` register.

If software does not set the `send_auto_stop` bit in the `cmd` register to 1, software must issue the `STOP` command just like in the open-ended case.

When the `dto` bit of the `rintsts` register is set, the data command is complete.

Table 11-17. cmd Register Settings for Single-Block and Multiple-Block Write (Part 1 of 2)

Parameter	Value	Comment
Default		
<code>start_cmd</code>	1	This bit resets itself to 0 after the command is committed (accepted by the BIU).
<code>use_hold_reg</code>	1 or 0	Choose the value based on speed mode being used.
<code>update_clk_regs_only</code>	0	Does not need to update clock parameters
<code>data_expected</code>	1	Data command
<code>card_number</code>	1	For one card
<code>transfer_mode</code>	0	Block transfer
<code>send_initialization</code>	0	Can be 1, but only for card reset commands such as SD/SDIO <code>GO_IDLE_STATE</code>
<code>stop_abort_cmd</code>	0	Can be 1 for commands to stop data transfer such as SD/SDIO <code>STOP_TRANSMISSION</code>
<code>send_auto_stop</code>	0 or 1	Set according to Table 11-10 on page 11-28
<code>read_write</code>	1	Write to card
<code>response_length</code>	0	Can be 1 for R2 (long) response
<code>response_expect</code>	1	Can be 0 for commands with no response. For example, SD/SDIO <code>GO_IDLE_STATE</code> , <code>SET_DSR</code> , <code>GO_INACTIVE_STATE</code> etc.

Table 11-17. cmd Register Settings for Single-Block and Multiple-Block Write (Part 2 of 2)

Parameter	Value	Comment
Default		
User-Selectable		
wait_prvdata_complete	1	0—Sends command to the CIU immediately 1—Sends command after previous data transfer ends
check_response_crc	1	0—Controller must not check response CRC 1—Controller must check response CRC
cmd_index	Command Index	Set this parameter to the command number. For example, set to 24 for SD/SDIO WRITE_BLOCK (CMD24) or 25 for WRITE_MULTIPLE_BLOCK (CMD25).

Stream Read and Write

In a stream transfer, if the byte count is equal to 0, the software must also send the SD/SDIO STOP command. If the byte count is not 0, when a given number of bytes completes a transfer, the controller sends the STOP command automatically. Completion of this AUTO_STOP command is reflected by the Auto_command_done interrupt. A response to an AUTO_STOP command is written to the resp1 register. A stream transfer is allowed only for card interfaces with a 1-bit data bus.

A stream read requires the same steps as the block read described in “[Single-Block or Multiple-Block Read](#)” on page 11-46, except for the following bits in the cmd register:

- transfer_mode = 0x1 (for stream transfer)
- cmd_index = 20 (SD/SDIO CMD20)

A stream write requires the same steps as the block write mentioned in “[Single-Block or Multiple-Block Write](#)” on page 11-48, except for the following bits in the cmd register:

- transfer_mode = 0x1 (for stream transfer)
- cmd_index = 11 (SD/SDIO CMD11)

Packed Commands

To reduce overhead, read and write commands can be packed in groups of commands—either all read or all write—that transfer the data for all commands in the group in one transfer on the bus. Use the SD/SDIO SET_BLOCK_COUNT (CMD23) command to state ahead of time how many blocks will be transferred. Then issue a single READ_MULTIPLE_BLOCK or WRITE_MULTIPLE_BLOCK command to read or write multiple blocks.

- SET_BLOCK_COUNT—set block count (number of blocks transferred using the READ_MULTIPLE_BLOCK or WRITE_MULTIPLE_BLOCK command)
- READ_MULTIPLE_BLOCK—multiple-block read command
- WRITE_MULTIPLE_BLOCK—multiple-block write command

Packed commands are organized in packets by the application software and are transparent to the controller.

 For more information about packed commands, refer to *JEDEC Standard No. 84-A441*, as referenced in “References” on page 11-79.

Transfer Stop and Abort Commands

This section describes stop and abort commands. The SD/SDIO STOP_TRANSMISSION command can terminate a data transfer between a memory card and the controller. The ABORT command can terminate an I/O data transfer for only an SDIO card.

STOP_TRANSMISSION (CMD12)

The host can send the STOP_TRANSMISSION (CMD12) command on the CMD pin at any time while a data transfer is in progress. Perform the following steps to send the STOP_TRANSMISSION command to the SD/SDIO card device:

1. Set the wait_prvdata_complete bit of the cmd register to 0.
2. Set the stop_abort_cmd in the cmd register to 1, which ensures that the CIU stops.

The STOP_TRANSMISSION command is a non-data transfer command. For more information, refer to “Non-Data Transfer Commands” on page 11-42.

ABORT

The ABORT command can only be used with SDIO cards. To abort the function that is transferring data, program the ABORT function number in the ASx[2:0] bits at address 0x06 of the card common control register (CCCR) in the card device, using the IO_RW_DIRECT (CMD52) command. The CCCR is located at the base of the card space 0x0 – 0xFF.

The ABORT command is a non-data transfer command. For more information, refer to “Non-Data Transfer Commands” on page 11-42.

Perform the following steps to send the ABORT command to the SDIO card device:

1. Set the cmdarg register to include the appropriate command argument parameters listed in Table 11-18.
2. Send the IO_RW_DIRECT command by setting the following fields of the cmd register:
 - Set the command index to 0x52 (IO_RW_DIRECT).
 - Set the stop_abort_cmd bit of the cmd register to 1 to inform the controller that the host aborted the data transfer.
 - Set the wait_prvdata_complete bit of the cmd register to 0.
3. Wait for the cmd bit in the rintsts register to change to 1.
4. Read the response to the IO_RW_DIRECT command (R5) in the response registers for any errors.


 For more information about response values, refer to the *Physical Layer Simplified Specification, Version 3.01* as described in “References” on page 11-79.

Table 11-18. cmdarg Register Settings for SD/SDIO ABORT Command

Bits	Contents	Value
31	R/W flag	1
30:28	Function number	0, for access to the CCCR in the card device
27	RAW flag	1, if needed to read after write
26	Don't care	-
25:9	Register address	0x06
8	Don't care	-
7:0	Write data	Function number to abort

Internal DMA Controller Operations

For better performance, you can use the internal DMA controller to transfer data between the host and the controller. This section describes the internal DMA controller's initialization process, and transmission sequence, and reception sequence.

Internal DMA Controller Initialization

To initialize the internal DMA controller, perform the following steps:

- Set the required `bmod` register bits:
 - If the internal DMA controller enable bit (`de`) of the `bmod` register is set to 0 during the middle of a DMA transfer, the change has no effect. Disabling only takes effect for a new data transfer command.
 - Issuing a software reset immediately terminates the transfer. Prior to issuing a software reset, Altera recommends the host reset the DMA interface by setting the `dma_reset` bit of the `ctrl1` register to 1.
 - The `pbl` field of the `bmod` register is read-only and a direct reflection of the contents of the DMA multiple transaction size field (`dw_dma_multiple_transaction_size`) in the `fifoth` register.
 - The `fb` bit of the `bmod` register has to be set appropriately for system performance.
- Write to the `idinten` register to mask unnecessary interrupt causes according to the following guidelines:
 - When a Descriptor Unavailable interrupt is asserted, the software needs to form the descriptor, appropriately set its own bit, and then write to the poll demand register (`pldmnd`) for the internal DMA controller to re-fetch the descriptor.
 - It is always appropriate for the software to enable abnormal interrupts because any errors related to the transfer are reported to the software.

3. Populate either a transmit or receive descriptor list in memory. Then write the base address of the first descriptor in the list to the internal DMA controller's descriptor list base address register (dbaddr). The DMA controller then proceeds to load the descriptor list from memory.

The next two sections, “Internal DMA Controller Transmission Sequences” and “Internal DMA Controller Reception Sequences” on page 11-54, describe this step in detail.

Internal DMA Controller Transmission Sequences

To use the internal DMA controller to transmit data, perform the following steps:

1. The host sets up the Descriptor fields (DES0—DES3) for transmission and sets the OWN bit (DES0[31]) to 1. The host also loads the data buffer in system memory with the data to be written to the SD card.
2. The host writes the appropriate write data command (SD/SDIO WRITE_BLOCK or WRITE_MULTIPLE_BLOCK) to the cmd register. The internal DMA controller determines that a write data transfer needs to be performed.
3. The host sets the required transmit threshold level in the tx_wmark field in the fifoth register.
4. The internal DMA controller engine fetches the descriptor and checks the OWN bit. If the OWN bit is set to 0, the host owns the descriptor. In this case, the internal DMA controller enters the suspend state and asserts the Descriptor Unable interrupt. The host then needs to set the descriptor OWN bit to 1 and release the DMA controller by writing any value to the pldmnd register.
5. The host must write the descriptor base address to the dbaddr register.
6. The internal DMA controller waits for the Command Done (CD) bit in the rintsts register to be set to 1, with no errors from the BIU. This condition indicates that a transfer can be done.
7. The internal DMA controller engine waits for a DMA interface request from BIU. The BIU divides each transfer into smaller chunks. Each chunk is an internal request to the DMA. This request is generated based on the transmit threshold value.
8. The internal DMA controller fetches the transmit data from the data buffer in the system memory and transfers the data to the FIFO buffer in preparation for transmission to the card.
9. When data spans across multiple descriptors, the internal DMA controller fetches the next descriptor and continues with its operation with the next descriptor. The Last Descriptor bit in the descriptor DES0 field indicates whether the data spans multiple descriptors or not.
10. When data transmission is complete, status information is updated in the idsts register by setting the ti bit to 1, if enabled. Also, the OWN bit is set to 0 by the DMA controller by updating the DES0 field of the descriptor.

Internal DMA Controller Reception Sequences

To use the internal DMA controller to receive data, perform the following steps:

1. The host sets up the descriptor fields (DES0—DES3) for reception, sets the OWN (DES0 [31]) to 1.
2. The host writes the read data command to the `cmd` register in BIU. The internal DMA controller determines that a read data transfer needs to be performed.
3. The host sets the required receive threshold level in the `rx_wmark` field in the `fifoth` register.
4. The internal DMA controller engine fetches the descriptor and checks the OWN bit. If the OWN bit is set to 0, the host owns the descriptor. In this case, the internal DMA controller enters suspend state and asserts the Descriptor Unable interrupt. The host then needs to set the descriptor OWN bit to 1 and release the DMA controller by writing any value to the `pldmnd` register.
5. The host must write the descriptor base address to the `dbaddr` register.
6. The internal DMA controller waits for the `CD` bit in the `rintsts` register to be set to 1, with no errors from the BIU. This condition indicates that a transfer can be done.
7. The internal DMA controller engine waits for a DMA interface request from the BIU. The BIU divides each transfer into smaller chunks. Each chunk is an internal request to the DMA. This request is generated based on the receive threshold value.
8. The internal DMA controller fetches the data from the FIFO buffer and transfers the data to system memory.
9. When data spans across multiple descriptors, the internal DMA controller fetches the next descriptor and continues with its operation with the next descriptor. The Last Descriptor bit in the descriptor indicates whether the data spans multiple descriptors or not.
10. When data reception is complete, status information is updated in the `idsts` register by setting the `ri` bit to 1, if enabled. Also, the OWN bit is set to 0 by the DMA controller by updating the DES0 field of the descriptor.

Commands for SDIO Card Devices

This section describes the commands to temporarily halt the transfers between the controller and SDIO card device.

Suspend and Resume Sequence

For SDIO cards, a data transfer between an I/O function and the controller can be temporarily halted using the SUSPEND command. This capability might be required to perform a high-priority data transfer with another function. When desired, the suspended data transfer can be resumed using the RESUME command.

The SUSPEND and RESUME operations are implemented by writing to the appropriate bits in the CCCR (Function 0) of the SDIO card. To read from or write to the CCCR, use the controller's IO_RW_DIRECT command.

Suspend

To suspend data transfer, perform the following steps:

1. Check if the SDIO card supports the SUSPEND/RESUME protocol. This can be done through the SBS bit in the CCCR at offset 0x08 of the card.
2. Check if the data transfer for the required function number is in process. The function number that is currently active is reflected in the function select bits (FSx) of the CCCR, bits 3:0 at offset 0x0D of the card.



If the bus status bit (BS), bit 0 at address 0xC, is 1, only the function number given by the FSx bits is valid.

3. To suspend the transfer, set the bus release bit (BR), bit 2 at address 0xC, to 1.
4. Poll the BR and BS bits of the CCCR at offset 0x0C of the card until they are set to 0. The BS bit is 1 when the currently-selected function is using the data bus. The BR bit remains 1 until the bus release is complete. When the BR and BS bits are 0, the data transfer from the selected function is suspended.
5. During a read-data transfer, the controller can be waiting for the data from the card. If the data transfer is a read from a card, the controller must be informed after the successful completion of the SUSPEND command. The controller then resets the data state machine and comes out of the wait state. To accomplish this, set the abort read data bit (abort_read_data) in the ctrl register to 1.
6. Wait for data completion, by polling until the dto bit is set to 1 in the rintsts register.

To determine the number of pending bytes to transfer, read the transferred CIU card byte count (tcbcnt) register of the controller. Subtract this value from the total transfer size. You use this number to resume the transfer properly.

Resume

To resume the data transfer, perform the following steps:

1. Check that the card is not in a transfer state, which confirms that the bus is free for data transfer.
2. If the card is in a disconnect state, select it using the SD/SDIO SELECT/DESELECT_CARD command. The card status can be retrieved in response to an IO_RW_DIRECT or IO_RW_EXTENDED command.
3. Check that a function to be resumed is ready for data transfer. Determine this state by reading the corresponding RF<n> flag in CCCR at offset 0x0F of the card. If RF<n> = 1, the function is ready for data transfer.



For detailed information about the RF<n> flags, refer to *SDIO Simplified Specification Version 2.00* as described in ["References" on page 11-79](#):

4. To resume transfer, use the `IO_RW_DIRECT` command to write the function number at the `FSx` bits in the `CCCR`, bits 3:0 at offset 0x0D of the card. Form the command argument for the `IO_RW_DIRECT` command and write it to the `cmdarg` register. Bit values are listed in [Table 11-19](#).

Table 11-19. cmdarg Bit Values for RESUME Command

Bits	Content	Value
31	R/W flag	1
30:28	Function number	0, for CCCR access
27	RAW flag	1, read after write
26	Don't care	-
25:9	Register address	0x0D
8	Don't care	-
7:0	Write data	Function number that is to be resumed

5. Write the block size value to the `blksiz` register. Data is transferred in units of this block size.
6. Write the byte count value to the `bytcnt` register. Specify the total size of the data that is the remaining bytes to be transferred. It is the responsibility of the software to handle the data.

To determine the number of pending bytes to transfer, read the transferred CIU card byte count register (`tcbcnt`). Subtract this value from the total transfer size to calculate the number of remaining bytes to transfer.
7. Write to the `cmd` register similar to a block transfer operation. When the `cmd` register is written, the command is sent and the function resumes data transfer. For more information, refer to [“Single-Block or Multiple-Block Read” on page 11-46](#) and [“Single-Block or Multiple-Block Write” on page 11-48](#).
8. Read the resume data flag (DF) of the SDIO card device. Interpret the DF flag as follows:
 - DF=1—The function has data for the transfer and begins a data transfer as soon as the function or memory is resumed.
 - DF=0—The function has no data for the transfer. If the data transfer is a read, the controller waits for data. After the data timeout period, it issues a data timeout error.

Read-Wait Sequence

Read_wait is used with SDIO cards only. It temporarily stalls the data transfer, either from functions or memory, and allows the host to send commands to any function within the SDIO card device. The host can stall this transfer for as long as required. The controller provides the facility to signal this stall transfer to the card. To signal the stall, perform the following steps:

1. Check if the card supports the read_wait facility by reading the SDIO card's SRW bit, bit 2 at offset 0x8 in the CCCR.
2. If this bit is 1, all functions in the card support the read_wait facility. Use the SD/SDIO IO_RW_DIRECT command to read this bit.
3. If the card supports the read_wait signal, assert it by setting the read wait bit (read_wait) in the ctrl register to 1.
4. Reset the read_wait bit to 0 in the ctrl register.

CE-ATA Data Transfer Commands

This section describes CE-ATA data transfer commands. For information about the basic settings and interrupts generated for different conditions, refer to [“Data Transfer Commands” on page 11-44](#).

Reset and Card Device Discovery Overview

Before starting any CE-ATA operations, the host must perform a MMC reset and initialization procedure. The host and card device must negotiate the MMC transfer (MMC TRAN) state before the card enters the MMC TRAN state.



For information about the MMC TRAN state, MMC reset and initialization, refer to *JEDEC Standard No. 84-A441*, as referenced in [“References” on page 11-79](#).

The host must follow the existing MMC discovery procedure to negotiate the MMC TRAN state. After completing normal MMC reset and initialization procedures, the host must query the initial ATA task file values using the RW_REG or CMD39 command.

By default, the MMC block size is 512 bytes—indicated by bits 1:0 of the srcControl register inside the CE-ATA card device. The host can negotiate the use of a 1 KB or 4 KB MMC block sizes. The card indicates MMC block sizes that it can support through the srcCapabilities register in the MMC; the host reads this register to negotiate the MMC block size. Negotiation is complete when the host controller writes the MMC block size into the srcControl register bits 1:0 of the card.

ATA Task File Transfer Overview

ATA task file registers are mapped to addresses 0x00h through 0x10h in the MMC register space. The RW_REG command is used to issue the ATA command, and the ATA task file is transmitted in a single RW_REG MMC command sequence.

The host software stack must write the task file image to the FIFO buffer before setting the cmdarg and cmd registers in the controller. The host processor then writes the address and byte count to the cmdarg register before setting the cmd register bits.

For the RW_REG command, there is no CCS from the CE-ATA card device.

ATA Task File Transfer Using the RW_MULTIPLE_REGISTER (RW_REG) Command

This command involves data transfer between the CE-ATA card device and the controller. To send a data command, the controller needs a command argument, total data size, and block size. Software receives or sends data through the FIFO buffer.

To implement an ATA task file transfer (read or write), perform the following steps:

1. Write the data size in bytes to the `bytcnt` register. `bytcnt` must equal the block size, because the controller expects a single block transfer.
2. Write the block size in bytes to the `blksiz` register.
3. Write the `cmdarg` register with the beginning register address.

You must set the `cmdarg`, `cmd`, `blksiz`, and `bytcnt` registers according to [Table 11-20](#) through [Table 11-23](#).

Table 11-20. cmdarg Register Settings for ATA Task File Transfer

Bit	Value	Comment
31	1 or 0	Set to 0 for read operation or set to 1 for write operation
30:24	0	Reserved (bits set to 0 by host processor)
23:18	0	Starting register address for read or write (DWORD aligned)
17:16	0	Register address (DWORD aligned)
15:8	0	Reserved (bits set to 0 by host processor)
7:2	16	Number of bytes to read or write (integral number of DWORD)
1:0	0	Byte count in integral number of DWORD

Table 11-21. cmd Register Settings for ATA Task File Transfer (Part 1 of 2)

Bit	Value	Comment
<code>start_cmd</code>	1	-
<code>ccs_expected</code>	0	CCS is not expected
<code>read_ceata_device</code>	0 or 1	Set to 1 if RW_BLK or RW_REG read
<code>update_clk_regs_only</code>	0	No clock parameters update command
<code>card_num</code>	0	-
<code>send_initialization</code>	0	No initialization sequence
<code>stop_abort_cmd</code>	0	-
<code>send_auto_stop</code>	0	-
<code>transfer_mode</code>	0	Block transfer mode. Block size and byte count must match number of bytes to read or write
<code>read_write</code>	1 or 0	1 for write and 0 for read
<code>data_expected</code>	1	Data is expected
<code>response_length</code>	0	-
<code>response_expect</code>	1	-
<code>cmd_index</code>	Command index	Set this parameter to the command number. For example, set to 24 for SD/SDIO WRITE_BLOCK (CMD24) or 25 for WRITE_MULTIPLE_BLOCK (CMD25).

Table 11-21. cmd Register Settings for ATA Task File Transfer (Part 2 of 2)

Bit	Value	Comment
wait_prvdata_complete	1	<ul style="list-style-type: none"> 0 for send command immediately 1 for send command after previous DTO interrupt
check_response_crc	1	<ul style="list-style-type: none"> 0 for not checking response CRC 1 for checking response CRC

Table 11-22. blksiz Register Settings for ATA Task File Transfer

Bits	Value	Comment
31:16	0	Reserved bits set to 0
15:0 (block_size)	16	For accessing entire task file (16, 8-bit registers). Block size of 16 bytes

Table 11-23. bytcnt Register Settings for ATA Task File Transfer

Bits	Value	Comment
31:0	16	For accessing entire task file (16, 8-bit registers). Byte count value of 16 is used with the block size set to 16.

ATA Payload Transfer Using the RW_MULTIPLE_BLOCK (RW_BLK) Command

This command involves data transfer between the CE-ATA card device and the controller. To send a data command, the controller needs a command argument, total data size, and block size. Software receives or sends data through the FIFO buffer.

To implement an ATA payload transfer (read or write), perform the following steps:

1. Write the data size in bytes to the bytcnt register.
2. Write the block size in bytes to the blksiz register. The controller expects a single/multiple block transfer.
3. Write to the cmdarg register to indicate the data unit count.

You must set the cmdarg, cmd, blksiz, and bytcnt registers according to [Table 11-24](#) through [Table 11-27](#).

Table 11-24. cmdarg Register Settings for ATA Payload Transfer

Bits	Value	Comment
31	1 or 0	Set to 0 for read operation or set to 1 for write operation
30:24	0	Reserved (bits set to 0 by host processor)
23:16	0	Reserved (bits set to 0 by host processor)
15:8	Data count	Data Count Unit [15:8]
7:0	Data count	Data Count Unit [7:0]

Table 11-25. cmd Register Settings for ATA Payload Transfer

Bits	Value	Comment
start_cmd	1	-
ccs_expected	1	CCS is expected. Set to 1 for the RW_BLK command if interrupts are enabled in CE-ATA card device (the <i>nIEN</i> bit is set to 0 in the ATA control register)
read_ceata_device	0 or 1	Set to 1 for a RW_BLK or RW_REG read command
update_clk_regs_only	0	No clock parameters update command
card_num	0	-
send_initialization	0	No initialization sequence
stop_abort_cmd	0	-
send_auto_stop	0	-
transfer_mode	0	Block transfer mode. Byte count must be integer multiple of 4kB. Block size can be 512, 1k or 4k bytes
read_write	1 or 0	1 for write and 0 for read
data_expected	1	Data is expected
response_length	0	-
response_expect	1	-
cmd_index	Command index	Set this parameter to the command number. For example, set to 24 for SD/SDIO WRITE_BLOCK (CMD24) or 25 for WRITE_MULTIPLE_BLOCK (CMD25).
wait_prvdata_complete	1	<ul style="list-style-type: none"> ■ 0 for send command immediately ■ 1 for send command after previous DTO interrupt
check_response_crc	1	<ul style="list-style-type: none"> ■ 0 for not checking response CRC ■ 1 for checking response CRC

Table 11-26. blksiz Register Settings for ATA Payload Transfer

Bits	Value	Comment
31:16	0	Reserved bits set to 0
15:0 (block_size)	512, 1024 or 4096	MMC block size can be 512, 1024 or 4096 bytes as negotiated by host

Table 11-27. bytcnt Register Settings for ATA Payload Transfer

Bits	Value	Comment
31:0	$\langle n \rangle * \text{block_size}$	<p>Byte count must be an integer multiple of the block size. For ATA media access commands, byte count must be a multiple of 4 KB.</p> <p>($\langle n \rangle * \text{block_size} = \langle x \rangle * 4 \text{ KB}$, where $\langle n \rangle$ and $\langle x \rangle$ are integers)</p>

CE-ATA CCS

This section describes disabling the CCS, recovery after CCS timeout, and recovery after I/O read transmission delay (N_{ACIO}) timeout.

Disabling the CCS

While waiting for the CCS for an outstanding RW_BLK command, the host can disable the CCS by sending a CCSD command:

- Send a CCSD command—the controller sends the CCSD command to the CE-ATA card device if the `send_ccsd` bit is set to 1 in the `ctrl` register of the controller. This bit can be set only after a response is received for the RW_BLK command.
- Send an internal stop command—send an internally-generated SD/SDIO STOP_TRANSMISSION (CMD12) command after sending the CCSD pattern. If the `send_auto_stop_ccsd` bit of the `ctrl` register is also set to 1 when the controller is set to send the CCSD pattern, the controller sends the internally-generated STOP command to the `CMD` pin. After sending the STOP command, the controller sets the `acd` bit in the `rintsts` register to 1.

Recovery after CCS Timeout

If a timeout occurs while waiting for the CCS, the host needs to send the CCSD command followed by a STOP command to abort the pending ATA command. The host can set up the controller to send an internally-generated STOP command after sending the CCSD pattern:

- Send CCSD command—set the `send_ccsd` bit in the `ctrl` register to 1.
- Send external STOP command—terminate the data transfer between the CE-ATA card device and the controller. For more information about sending the STOP command, refer to [“Transfer Stop and Abort Commands” on page 11-51](#).
- Send internal STOP command—set the `send_auto_stop_ccsd` bit in the `ctrl` register to 1, which tells the controller to send the internally-generated STOP command. After sending the STOP command, the controller sets the `acd` bit in the `rintsts` register to 1. The `send_auto_stop_ccsd` bit must be set to 1 along with setting the `send_ccsd` bit.

Recovery after I/O Read Transmission Delay (N_{ACIO}) Timeout

If the I/O read transmission delay (N_{ACIO}) timeout occurs for the CE-ATA card device, perform one of the following steps to recover from the timeout:

- If the CCS is expected from the CE-ATA card device (that is, the `ccs_expected` bit is set to 1 in the `cmd` register), follow the steps in [“Recovery after CCS Timeout” on page 11-61](#).
- If the CCS is not expected from the CE-ATA card device, perform the following steps:
 - a. Send an external STOP command.
 - b. Terminate the data transfer between the controller and CE-ATA card device.

Reduced ATA Command Set

It is necessary for the CE-ATA card device to support the reduced ATA command subset. This section describes the reduced command set.

The IDENTIFY DEVICE Command

The IDENTIFY DEVICE command returns a 512-byte data structure to the host that describes device-specific information and capabilities. The host issues the IDENTIFY DEVICE command only if the MMC block size is set to 512 bytes. Any other MMC block size has indeterminate results.

The host issues a RW_REG command for the ATA command, and the data is retrieved with the RW_BLK command.

The host controller uses the following settings while sending a RW_REG command for the IDENTIFY DEVICE ATA command. The following list shows the primary bit settings:

- cmd register setting: data_expected bit set to 0
- cmdarg register settings:
 - Bit [31] set to 0
 - Bits [7:2] set to 128
 - All other bits set to 0
- Task file settings:
 - Command field of the ATA task file set to 0xEC
 - Reserved fields of the task file set to 0
- bytcnt register and block_size field of the blksiz register: set to 16

The host controller uses the following settings for data retrieval (RW_BLK command):

- cmd register settings:
 - ccs_expected set to 1
 - data_expected set to 1
- cmdarg register settings:
 - Bit [31] set to 0 (read operation)
 - Bits [15:0] set to 1 (data unit count = 1)
 - All other bits set to 0
- bytcnt register and block_size field of the blksiz register: set to 512

The READ DMA EXT Command

The READ DMA EXT command reads a number of logical blocks of data from the card device using the Data-In data transfer protocol. The host uses a RW_REG command to issue the ATA command and the RW_BLK command for the data transfer.

The WRITE DMA EXT Command

The WRITE DMA EXT command writes a number of logical blocks of data to the card device using the Data-Out data transfer protocol. The host uses a RW_REG command to issue the ATA command and the RW_BLK command for the data transfer.

The STANDBY IMMEDIATE Command

This ATA command causes the card device to immediately enter the most aggressive power management mode that still retains internal device context. No data transfer (RW_BLK) is expected for this command.

For card devices that do not provide a power savings mode, the STANDBY IMMEDIATE command returns a successful status indication. The host issues a RW_REG command for the ATA command, and the status is retrieved with the SD/SDIO CMD39 or RW_REG command. Only the status field of the ATA task file contains the success status; there is no error status.

The host controller uses the following settings while sending the RW_REG command for the STANDBY IMMEDIATE ATA command:

- cmd register setting: data_expected bit set to 0
- cmdarg register settings:
 - Bit [31] set to 1
 - Bits [7:2] set to 4
 - All other bits set to 0
- Task file settings:
 - Command field of the ATA task file set to 0xE0
 - Reserved fields of the task file set to 0
- bytcnt register and block_size field of the blksiz register: set to 16

The FLUSH CACHE EXT Command

For card devices that buffer/cache written data, the FLUSH CACHE EXT command ensures that buffered data is written to the card media. For cards that do not buffer written data, the FLUSH CACHE EXT command returns a success status. No data transfer (RW_BLK) is expected for this ATA command.

The host issues a RW_REG command for the ATA command, and the status is retrieved with the SD/SDIO CMD39 or RW_REG command. There can be error status for this ATA command, in which case fields other than the status field of the ATA task file are valid.

The host controller uses the following settings while sending the RW_REG command for the STANDBY IMMEDIATE ATA command:

- cmd register setting: data_expected bit set to 0
- cmdarg register settings:
 - Bit [31] set to 1
 - Bits [7:2] set to 4
 - All other bits set to 0

- Task file settings:
 - Command field of the ATA task file set to 0xEA
 - Reserved fields of the task file set to 0
- `bytcnt` register and `block_size` field of the `blksiz` register: set to 16

Card Read Threshold

When an application needs to perform a single or multiple block read command, the application must set the `cardthrc1` register with the appropriate card read threshold size in the card read threshold field (`cardrdthreshold`) and set the `cardrdthren` bit to 1. This additional information specified in the controller ensures that the controller sends a read command only if there is space equal to the card read threshold available in the RX FIFO buffer. This in turn ensures that the card clock is not stopped in the middle a block of data being transmitted from the card. Set the card read threshold to the block size of the transfer to guarantee there is a minimum of one block size of space in the RX FIFO buffer before the controller enables the card clock.

The card read threshold is required when the round trip delay is greater than half of `sdmmc_clk_divided`.

Recommended Usage Guidelines for Card Read Threshold

1. The `cardthrc1` register must be set before setting the `cmd` register for a data read command.
2. The `cardthrc1` register must not be set while a data transfer command is in progress.
3. The `cardrdthreshold` field of the `cardthrc1` register must be set to at the least the block size of a single or multiblock transfer. A `cardrdthreshold` field setting greater than or equal to the block size of the read transfer ensures that the card clock does not stop in the middle of a block of data.
4. If the round trip delay is greater than half of the card clock period, card read threshold must be enabled and the card threshold must be set as per guideline 3 to guarantee that the card clock does not stop in the middle of a block of data.
5. If the `cardrdthreshold` field is set to less than the block size of the transfer, the host must ensure that the receive FIFO buffer never overflows during the read transfer. Overflow can cause the card clock from the controller to stop. The controller is not able to guarantee that the card clock does not stop during a read transfer.



If the `cardrdthreshold` field of the `cardthrc1` register, and the `rx_wmark` and `dw_dma_multiple_transaction_size` fields of the `fifoth` register are set incorrectly, the card clock might stop indefinitely, with no interrupts generated by the controller.

Card Read Threshold Programming Sequence

Most cards, such as SDHC or SDXC, support block sizes that are either specified in the card or are fixed to 512 bytes. For SDIO, MMC, and standard capacity SD cards that support partial block read (`READ_BL_PARTIAL` set to 1 in the CSD register of the card device), the block size is variable and can be chosen by the application.

To use the card read threshold feature effectively and to guarantee that the card clock does not stop because of a FIFO Full condition in the middle of a block of data being read from the card, follow these steps:

1. Choose a block size that is a multiple of four bytes.
2. Enable card read threshold feature. The card read threshold can be enabled only if the block size for the given transfer is less than or equal to the total depth of the FIFO buffer:
 $(\text{block size} / 4) \leq 1024$
3. Choose the card read threshold value:
 - If $(\text{block size} / 4) \geq 512$, choose `cardrdthreshold` such that $\text{cardrdthreshold} \leq (\text{block size} / 4)$ in bytes
 - If $(\text{block size} / 4) < 512$, choose `cardrdthreshold` such that $\text{cardrdthreshold} = (\text{block size} / 4)$ in bytes
4. Set the `dw_dma_multiple_transaction_size` field in the `fifoth` register to the number of transfers that make up a DMA transaction. For example, `size = 1` means 4 bytes are moved. The possible values for the size are 1, 4, 8, 16, 32, 64, 128, and 256 transfers. Select the size so that the value $(\text{block size} / 4)$ is evenly divided by the size.
5. Set the `rx_wmark` field in the `fifoth` register to the `size - 1`.

For example, if your block size is 512 bytes, legal values of `dw_dma_multiple_transaction_size` and `rx_wmark` are listed in [Table 11-28](#).

Table 11-28. Legal Values of `dw_dma_multiple_transaction_size` and `rx_wmark` for Block Size = 512

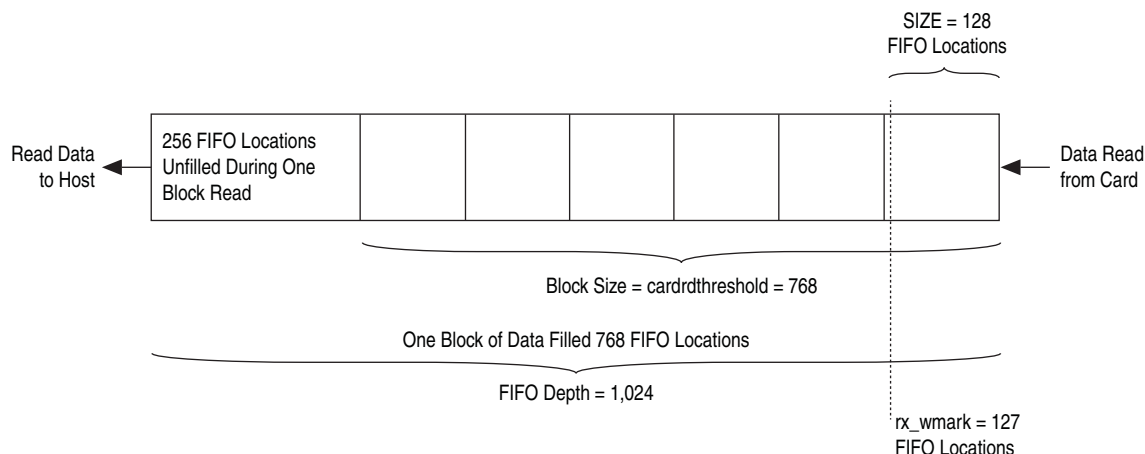
Block Size	<code>dw_dma_multiple_transaction_size</code>	<code>rx_wmark</code>
512	1	0
512	4	3
512	8	7
512	16	15
512	32	31
512	64	63
512	128	127

Card Read Threshold Programming Examples

This section shows examples of how to program the card read threshold.

- Choose a block size that is a multiple of 4 (the number of bytes per FIFO location), and less than 4096 (1024 FIFO locations). For example, a block size of 3072 bytes is legal, because $3072 / 4 = 768$ FIFO locations.
- For DMA mode, choose the size so that block size is a multiple of the size. For example `size = 128`, where $\text{block size} \% \text{size} = 0$.

- Set the `rx_wmark` field = size - 1. For example, the `rx_wmark` field = $128 - 1 = 127$.
- Because block size > $\frac{1}{2}$ `FifoDepth`, set the `cardrdthreshold` field to the block size. For example, the `cardrdthreshold` field = 3072 bytes.

Figure 11–12. FIFO Buffer content when Card Read Threshold is set to 768

Interrupt and Error Handling

This section describes how to use interrupts to handle errors. On power-on or reset, interrupts are disabled (the `int_enable` bit in the `ctrl` register is set to 0), and all the interrupts are masked (the `intmask` register default is 0). The controller error handling includes the following types of errors:

- Response and data timeout errors—For response time-outs, the host software can retry the command. For data time-outs, the controller has not received the data start bit from the card, so software can either retry the whole data transfer again or retry from a specified block onwards. By reading the contents of the `tcbsent` register later, the software can decide how many bytes remain to be copied (read).
- Response errors—Set to 1 when an error is received during response reception. If the response received is invalid, the software can retry the command.
- Data errors—Set to 1 when a data receive error occurs. Examples of data receive errors:
 - Data CRC
 - Start bit not found
 - End bit not found

These errors can occur on any block. On receipt of an error, the software can issue an SD/SDIO STOP or SEND_IF_COND command, and retry the command for either the whole data or partial data.

- Hardware locked error—Set to 1 when the controller cannot load a command issued by software. When software sets the `start_cmd` bit in the `cmd` register to 1, the controller tries to load the command. If the command buffer already contains a command, this error is raised, and the new command is discarded, requiring the software to reload the command.

- FIFO buffer underrun/overflow error—If the FIFO buffer is full and software tries to write data to the FIFO buffer, an overflow error is set. Conversely, if the FIFO buffer is empty and the software tries to read data from the FIFO buffer, an underrun error is set. Before reading or writing data in the FIFO buffer, the software must read the FIFO buffer empty bit (`fifo_empty`) or FIFO buffer full bit (`fifo_full`) in the status register.
- Data starvation by host timeout—This condition occurs when software does not service the FIFO buffer fast enough to keep up with the controller. Under this condition and when a read transfer is in process, the software must read data from the FIFO buffer, which creates space for further data reception. When a transmit operation is in process, the software must write data to fill the FIFO buffer so that the controller can write the data to the card.
- CE-ATA errors
 - CRC error on command—If a CRC error is detected for a command, the CE-ATA card device does not send a response, and a response timeout is expected from the controller. The ATA layer is notified that an MMC transport layer error occurred.
 - Write operation—Any MMC transport layer error known to the card device causes an outstanding ATA command to be terminated. The ERR bits are set in the ATA status registers and the appropriate error code is sent to the Error Register (Error) on the ATA card device.

If the device interrupt bit of the CE-ATA card (the `nIEN` bit in the ATA control register) is set to 0, the CCS is sent to the host.

If the device interrupt bit is set to 1, the card device completes the entire data unit count if the host controller does not abort the ongoing transfer.



During a multiple-block data transfer, if a negative CRC status is received from the card device, the data path signals a data CRC error to the BIU by setting the `dcrc` bit in the `rintsts` register to 1. It then continues further data transmission until all the bytes are transmitted.

- Read operation—If MMC transport layer errors are detected by the host controller, the host completes the ATA command with an error status. The host controller can issue a CCSD command followed by a STOP_TRANSMISSION (CMD12) command to abort the read transfer. The host can also transfer the entire data unit count bytes without aborting the data transfer.

Booting Operation for eMMC and MMC

This section describes how to set up the controller for eMMC and MMC boot operation.

Boot Operation by Holding Down the CMD Line

The controller can boot from MMC4.3, MMC4.4, and MMC4.41 cards by holding down the CMD line.



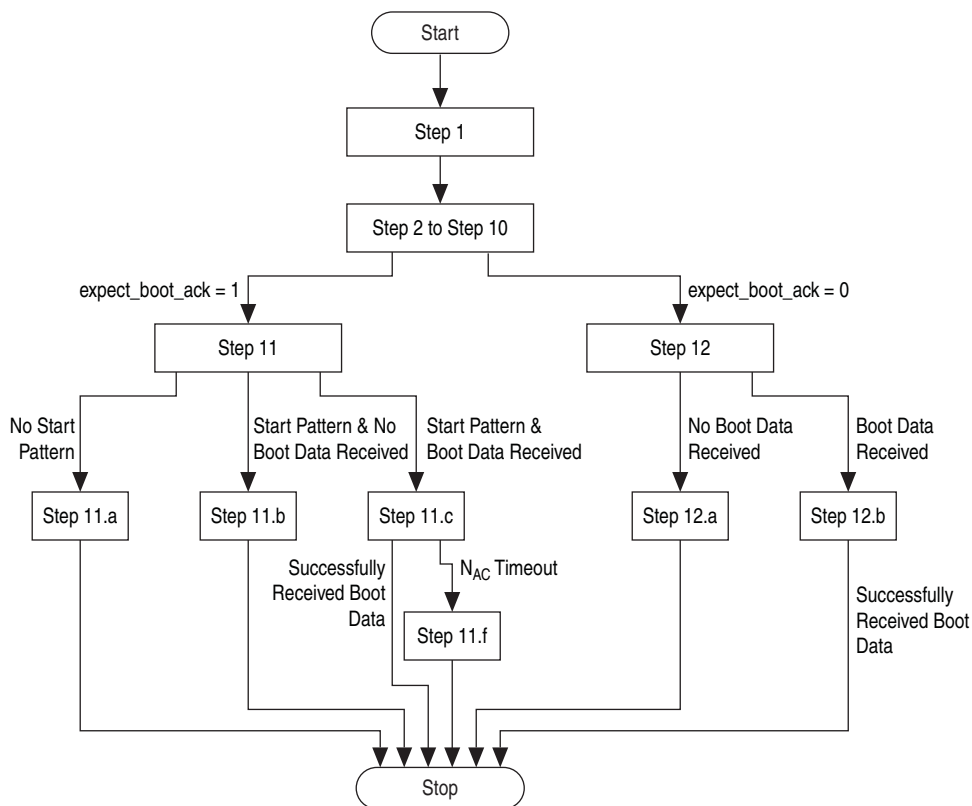
For information about this boot method, refer to the following specifications, as referenced in “References” on page 11-79:

- JEDEC Standard No. 84-A441
- JEDEC Standard No. 84-A44
- JEDEC Standard No. JESD84-A43

Boot Operation for eMMC Card Device


Figure 11-13 illustrates the steps to perform the boot process for eMMC card devices. The detailed steps are described following the flow chart.

Figure 11-13. Flow for eMMC Boot Operation



1. The software driver performs the following checks:
 - If the eMMC card device supports boot operation (the BOOT_PARTITION_ENABLE bit is set to 1 in the EXT_CSD register of the eMMC card).
 - The BOOT_SIZE_MULT and BOOT_BUS_WIDTH values in the EXT_CSD register, to be used during the boot process.

2. The software sets the following bits:
 - Sets masks for interrupts, by setting the appropriate bits to 0 in the `intmask` register.
 - Sets the global `int_enable` bit of the `ctrl` register to 1. Other bits in the `ctrl` register must be set to 0.

 Altera recommends that you write 0xFFFFFFFF to the `rintsts` and `idsts` registers to clear any pending interrupts before setting the `int_enable` bit. For internal DMA controller mode, the software driver needs to unmask all the relevant fields in the `idinten` register.
3. If the software driver needs to use the internal DMA controller to transfer the boot data received, it must perform the following steps:
 - Set up the descriptors as described in “Internal DMA Controller Transmission Sequences” on page 11-53 and “Internal DMA Controller Reception Sequences” on page 11-54.
 - Set the `use_internal_dmac` bit of the `ctrl` register to 1.
4. Set the card device frequency to 400 kHz using the `clkdiv` registers. For more information, refer to “Clock Setup” on page 11-40.
5. Set the `data_timeout` field of the `tmout` register equal to the card device total access time, N_{AC} .
6. Set the `blksiz` register to 0x200 (512 bytes).
7. Set the `bytcnt` register to a multiple of 128 KB, as indicated by the `BOOT_SIZE_MULT` value in the card device.
8. Set the `rx_wmark` field in the `fifoth` register. Typically, the threshold value can be set to 512, which is half the FIFO buffer depth.
9. Set the following fields in the `cmd` register:
 - Initiate the command by setting `start_cmd` = 1
 - Enable boot (`enable_boot`) = 1
 - Expect boot acknowledge (`expect_boot_ack`):
 - If a start-acknowledge pattern is expected from the card device, set `expect_boot_ack` to 1.
 - If a start-acknowledge pattern is not expected from the card device, set `expect_boot_ack` to 0.
 - Card number (`card_number`) = 0
 - `data_expected` = 1
 - Reset the remainder of `cmd` register bits to 0
10. If no start-acknowledge pattern is expected from the card device (`expect_boot_ack` set to 0) proceed to step 12.

11. This step handles the case where a start-acknowledge pattern is expected (expect_boot_ack was set to 1 in step 9).

- a. If the Boot ACK Received interrupt is not received from the controller within 50 ms of initiating the command (step 9), the software driver must set the following cmd register fields:

- start_cmd = 1
- Disable boot (disable_boot)= 1
- card_number = 0
- All other fields = 0

The controller generates a Command Done interrupt after deasserting the CMD pin of the card interface.

If internal DMA controller mode is used for the boot process, the controller performs the following steps after the Boot ACK Received timeout:

- The DMA descriptor is closed.
- The ces bit in the idsts register is set, indicating the Boot ACK Received timeout.
- The ri bit of the idsts register is not set.

- b. If the Boot ACK Received interrupt is received, the software driver must clear this interrupt by writing 1 to the ces bit in the idsts register.

Within 0.95 seconds of the Boot ACK Received interrupt, the Boot Data Start interrupt must be received from the controller. If this does not occur, the software driver must write the following cmd register fields:

- start_cmd = 1
- disable_boot = 1
- card_number = 0
- All other fields = 0

The controller generates a Command Done interrupt after deasserting the CMD pin of the card interface.

If internal DMA controller mode is used for the boot process, the controller performs the following steps after the Boot ACK Received timeout:

- The DMA descriptor is closed
- The ces bit in the idsts register is set, indicating Boot Data Start timeout
- The ri bit of the idsts register is not set

- c. If the Boot Data Start interrupt is received, it indicates that the boot data is being received from the card device. When the DMA engine is not in internal DMA controller mode, the software driver can then initiate a data read from the controller based on the rxdr interrupt bit in the rintsts register.

In internal DMA controller mode, the DMA engine starts transferring the data from the FIFO buffer to the system memory as soon as the level set in the rx_wmark field of the fifoth register is reached.

At the end of a successful boot data transfer from the card, the following interrupts are generated:

- The cmd bit and dto bit in the rintsts register
 - The ri bit in the idsts register, in internal DMA controller mode only
- d. If an error occurs in the boot ACK pattern (0b010) or an EBE occurs:
- The controller automatically aborts the boot process by pulling the CMD line high
 - The controller generates a Command Done interrupt
 - The controller does not generate a Boot ACK Received interrupt
 - The application aborts the boot transfer
- e. In internal DMA controller mode:
- If the software driver creates more descriptors than required by the received boot data, the extra descriptors are not closed by the controller. Software cannot reuse the descriptors until they are closed.
 - If the software driver creates fewer descriptors than required by the received boot data, the controller generates a Descriptor Unavailable interrupt and does not transfer any further data to system memory.
- f. If N_{AC} is violated between data block transfers, the DRTO interrupt is asserted. In addition, if there is an error associated with the start or end bit, the SBE or EBE interrupt is also generated.

The boot operation for eMMC card devices is complete. Do not execute the remaining step (12).

12. This step handles the case where no start-acknowledge pattern is expected (expect_boot_ack was set to 0 in step 9).
- If the Boot Data Start interrupt is not received from the controller within 1 second of initiating the command (step 9), the software driver must write the cmd register with the following fields:

- start_cmd = 1
- disable_boot = 1
- card_number = 0
- All other fields = 0

The controller generates a Command Done interrupt after deasserting the CMD line of the card. In internal DMA controller mode, the descriptor is closed and the ces bit in the idsts register is set to 1, indicating a Boot Data Start timeout.

- If a Boot Data Start interrupt is received, it indicates that the boot data is being received from the card device. When the DMA engine is not in internal DMA controller mode, the software driver can then initiate a data read from the controller based on the rxdr interrupt bit in the rintsts register.

In internal DMA controller mode, the DMA engine starts transferring the data from the FIFO buffer to the system memory as soon as the level specified in the rx_wmark field of the fifoth register is reached.

At the end of a successful boot data transfer from the card, the following interrupts are generated:

- The cmd bit and dto bit in the rintsts register
 - The ri bit in the idsts register, in internal DMA controller mode only
- In internal DMA controller mode:
 - If the software driver creates more descriptors than required by the received boot data, the extra descriptors are not closed by the controller.
 - If the software driver creates fewer descriptors than required by the received boot data, the controller generates a Descriptor Unavailable interrupt and does not transfer any further data to system memory.

The boot operation for eMMC card devices is complete.

Boot Operation for Removable MMC4.3, MMC4.4 and MMC4.41 Cards

Removable MMC4.3, MMC4.4, and MMC4.41 cards differ with respect to eMMC in that the controller is not aware whether these cards support the boot mode of operation when plugged in. Thus, the controller must:

- Discover these cards as it would discover MMC4.0/4.1/4.2 cards for the first time
- Know the card characteristics
- Decide whether to perform a boot operation or not

For these cards, the software driver must perform the following steps:

1. Discover the card as described in [“Enumerated Card Stack” on page 11-37](#).
2. Read the EXT_CSD register of the card and examine the following fields:
 - BOOT_PARTITION_ENABLE
 - BOOT_SIZE_MULT
 - BOOT_INFO
3. If necessary, the software can manipulate the boot information in the card.
 - For more information, refer to “Access to Boot Partition” in the following specifications, as referenced in [“References” on page 11-79](#):
 - JEDEC Standard No. 84-A441
 - JEDEC Standard No. 84-A44
 - JEDEC Standard No. JESD84-A43
4. If the host processor needs to perform a boot operation at the next power-up cycle, it can manipulate the EXT_CSD register contents by using a SWITCH_FUNC command.
5. After this step, the software driver must power down the card by writing to the pwren register.
6. From here on, use the same steps as in [“Alternative Boot Operation for eMMC Card Devices” on page 11-74](#).

Alternative Boot Operation

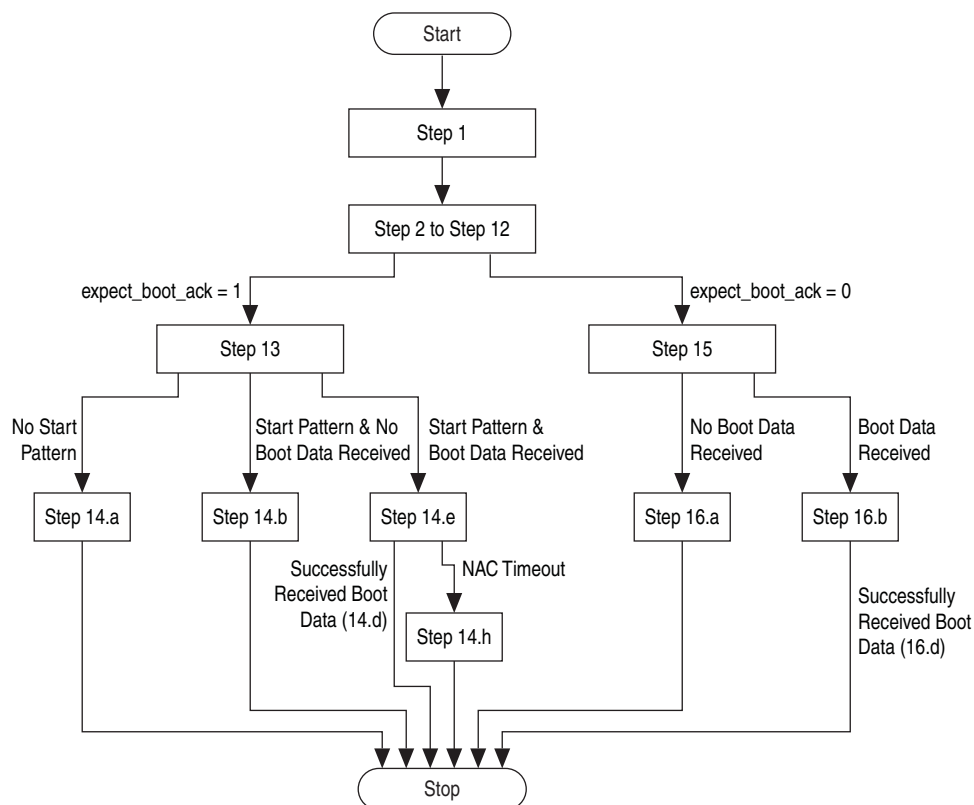
The alternative boot operation differs from the previous boot operation in that software uses the SD/SDIO GO_IDLE_STATE command to boot the card, rather than holding down the CMD line of the card. The alternative boot operation can be performed only if bit 0 in the BOOT_INFO register is set to 1. BOOT_INFO is located at offset 228 in the EXT_CSD registers.

- For detailed information about alternative boot operation, refer to the following specifications, as referenced in [“References” on page 11-79](#):
 - JEDEC Standard No. 84-A441
 - JEDEC Standard No. 84-A44
 - JEDEC Standard No. JESD84-A43

Alternative Boot Operation for eMMC Card Devices

Figure 11-14 illustrates the sequence of steps required to perform the alternative boot operation for eMMC card devices. The detailed steps are described following the flow chart.

Figure 11-14. Flow for eMMC Alternative Boot Operation



1. The software driver checks:
 - If the eMMC card device supports alternative boot operation (the BOOT_INFO bit is set to 1 in the eMMC card).
 - The BOOT_SIZE_MULT and BOOT_BUS_WIDTH values in the card device to use during the boot process.
2. The software sets the following bits:
 - Sets masks for interrupts by resetting the appropriate bits to 0 in the intmask register.
 - Sets the int_enable bit of the ctrl register to 1. Other bits in the ctrl register must be set to 0.



Altera recommends writing 0xFFFFFFFF to the rintsts register and idsts register to clear any pending interrupts before setting the int_enable bit. For internal DMA controller mode, the software driver needs to unmask all the relevant fields in the idinten register.

3. If the software driver needs to use the internal DMA controller to transfer the boot data received, it must perform the following actions:
 - Set up the descriptors as described in “Internal DMA Controller Transmission Sequences” on page 11-53 and “Internal DMA Controller Reception Sequences” on page 11-54.
 - Set the use internal DMAC bit (`use_internal_dmac`) of the `ctrl` register to 1.
4. Set the card device frequency to 400 kHz using the `clkdiv` registers. For more information, refer to “Clock Setup” on page 11-40. Ensure that the card clock is running.
5. Wait for a time that ensures that at least 74 card clock cycles have occurred on the card interface.
6. Set the `data_timeout` field of the `tmout` register equal to the card device total access time, N_{AC} .
7. Set the `blksiz` register to 0x200 (512 bytes).
8. Set the `bytcnt` register to multiples of 128K bytes, as indicated by the `BOOT_SIZE_MULT` value in the card device.
9. Set the `rx_wmark` field in the `fifoth` register. Typically, the threshold value can be set to 512, which is half the FIFO buffer depth.
10. Set the `cmdarg` register to 0xFFFFFFFF.
11. Initiate the command, by setting the `cmd` register with the following fields:
 - `start_cmd` = 1
 - `enable_boot` = 1
 - `expect_boot_ack`:
 - If a start-acknowledge pattern is expected from the card device, set `expect_boot_ack` to 1.
 - If a start-acknowledge pattern is not expected from the card device, set `expect_boot_ack` to 0.
 - `card_number` = 0
 - `data_expected` = 1
 - `cmd_index` = 0
 - Set the remainder of `cmd` register bits to 0.
12. If no start-acknowledge pattern is expected from the card device (`expect_boot_ack` set to 0) jump to step 15.
13. Wait for the Command Done interrupt.

14. This step handles the case where a start-acknowledge pattern is expected (expect_boot_ack was set to 1 in step 11).

- a. If the Boot ACK Received interrupt is not received from the controller within 50 ms of initiating the command (step 11), the start pattern was not received. The software driver must discontinue the boot process and start with normal discovery.

If internal DMA controller mode is used for the boot process, the controller performs the following steps after the Boot ACK Received timeout:

- The DMA descriptor is closed.
- The ces bit in the idsts register is set to 1, indicating the Boot ACK Received timeout.
- The ri bit of the idsts register is not set.

- b. If the Boot ACK Received interrupt is received, the software driver must clear this interrupt by writing 1 to it.

Within 0.95 seconds of the Boot ACK Received interrupt, the Boot Data Start interrupt must be received from the controller. If this does not occur, the software driver must discontinue the boot process and start with normal discovery.

If internal DMA controller mode is used for the boot process, the controller performs the following steps after the Boot ACK Received timeout:

- The DMA descriptor is closed.
- The ces bit in the idsts register is set to 1, indicating Boot Data Start timeout.
- The ri bit of the idsts register is not set.

- c. If the Boot Data Start interrupt is received, it indicates that the boot data is being received from the card device. When the DMA engine is not in internal DMA controller mode, the software driver can then initiate a data read from the controller based on the rxdr interrupt bit in the rintsts register.

In internal DMA controller mode, the DMA engine starts transferring the data from the FIFO buffer to the system memory as soon as the level specified in the rx_wmark field of the fifoth register is reached.

- d. The software driver must terminate the boot process by instructing the controller to send the SD/SDIO GO_IDLE_STATE command:

- Reset the cmdarg register to 0.
- Set the start_cmd bit of the cmd register to 1, and all other bits to 0.

- e. At the end of a successful boot data transfer from the card, the following interrupts are generated:

- The cmd bit and dto bit in the rintsts register
- The ri bit in the idsts register, in internal DMA controller mode only

- f. If an error occurs in the boot ACK pattern (0b010) or an EBE occurs:
 - The controller does not generate a Boot ACK Received interrupt.
 - The controller detects Boot Data Start and generates a Boot Data Start interrupt.
 - The controller continues to receive boot data.
 - The application must abort the boot process after receiving a Boot Data Start interrupt.
- g. In internal DMA controller mode:
 - If the software driver creates more descriptors than required by the received boot data, the extra descriptors are not closed by the controller.
 - If the software driver creates fewer descriptors than required by the received boot data, the controller generates a Descriptor Unavailable interrupt and does not transfer any further data to system memory.
- h. If N_{AC} is violated between data block transfers, a DRTO interrupt is asserted. Apart from this, if there is an error associated with the start or end bit, the SBE or EBE interrupt is also generated.

The alternative boot operation for eMMC card devices is complete. Do not execute the remaining steps (15 and 16).

15. Wait for the Command Done interrupt.

16. This step handles the case where a start-acknowledge pattern is not expected (expect_boot_ack was set to 0 in step 11).

- a. If the Boot Data Start interrupt is not received from the controller within 1 second of initiating the command (step 11), the software driver must discontinue the boot process and start with normal discovery.

In internal DMA controller mode:

- The DMA descriptor is closed.
- The ces bit in the idsts register is set to 1, indicating Boot Data Start timeout.
- The ri bit of the idsts register is not set.
- b. If a Boot Data Start interrupt is received, the boot data is being received from the card device. When the DMA engine is not in internal DMA controller mode, the software driver can then initiate a data read from the controller based on the rxdr interrupt bit in the rintsts register.

In internal DMA controller mode, the DMA engine starts transferring the data from the FIFO buffer to the system memory as soon as the level specified in the rx_wmark field of the fifoth register is reached.

- c. The software driver must terminate the boot process by instructing the controller to send the SD/SDIO GO_IDLE_STATE (CMD0) command:
 - Reset the cmdarg register to 0.
 - Set the start_cmd bit in the cmd register to 1, and all other bits to 0.

- d. At the end of a successful boot data transfer from the card, the following interrupts are generated:
 - The cmd bit and dto bit in the rintsts register
 - The ri bit in the idsts register, in internal DMA controller mode only
- e. In internal DMA controller mode:
 - If the software driver creates more descriptors than required by the received boot data, the extra descriptors are not closed by the controller.
 - If the software driver creates fewer descriptors than required by the received boot data, the controller generates a Descriptor Unavailable interrupt and does not transfer any further data to system memory.

The alternative boot operation for eMMC card devices is complete.


Alternative Boot Operation for MMC4.3 Cards

Removable MMC4.3 cards differ with respect to eMMC in that the controller is not aware whether these cards support the boot mode of operation. Thus, the controller must:

1. Discover these cards as it would discover MMC4.0/4.1/4.2 cards for the first time
2. Know the card characteristics
3. Decide whether to perform a boot operation or not

For these cards, the software driver must perform the following steps:

1. Discover the card as described in [“Enumerated Card Stack” on page 11-37](#).
2. Read the MMC card device’s EXT_CSD registers and examine the following fields:
 - BOOT_PARTITION_ENABLE
 - BOOT_SIZE_MULT
 - BOOT_INFO

 For more information, refer to “Access to Boot Partition” in *JEDEC Standard No. JESD84-A43*, as referenced in [“References” on page 11-79](#).
3. If the host processor needs to perform a boot operation at the next power-up cycle, it can manipulate the contents of the EXT_CSD registers in the MMC card device, by using a SWITCH_FUNC command.
4. After this step, the software driver must power down the card by writing to the pwren register.
5. From here on, use the same steps as in [“Alternative Boot Operation for eMMC Card Devices” on page 11-74](#).



Ignore the EBE if it is generated during an abort scenario.

If a boot acknowledge error occurs, the boot acknowledge received interrupt times out.

In internal DMA controller mode, the application needs to depend on the descriptor close interrupt instead of the data done interrupt.

SD/MMC Controller Address Map and Register Definitions



The address map and register definitions reside in the [hps.html](#) file that accompanies this handbook volume. Click the link to open the file.

To view the module description and base address, scroll to and click the following link:

■ [sdmmc](#)

To then view the register and field descriptions, scroll to and click the register names. The register addresses are offsets relative to the base address of each module instance.



The base addresses of all modules are also listed in the *Introduction to the Hard Processor System* chapter in volume 3 of the Cyclone V Device Handbook.

References



The following industry specifications provide detailed information about the standards and protocols implemented by the SD/MMC controller.

The following specifications are available on the JEDEC website (www.jedec.org):

- JEDEC Standard No. 84-A441—*Embedded MultiMediaCard (eMMC) eMMC/Card Product Standard, High Capacity, including Reliable Write, Boot, Sleep Modes, Dual Data Rate, Multiple Partitions Supports, Security Enhancement, Background Operation and High Priority Interrupt (MMCA, 4.41)*
- JEDEC Standard No. 84-A44—*Embedded MultiMediaCard (eMMC) eMMC/Card Product Standard, High Capacity, including Reliable Write, Boot, Sleep Modes, Dual Data Rate, Multiple Partitions Supports and Security Enhancement (MMCA, 4.4)*
- JEDEC Standard No. JESD84-A43—*Embedded MultiMediaCard (eMMC) eMMC/Card Product Standard, High Capacity, including Reliable Write, Boot, and Sleep Modes (MMCA, 4.3)*

The following specifications are available on the SD Association website (www.sdcard.org):

- *Physical Layer Simplified Specification, Version 3.01—SD Specifications Part 1 Physical Layer Simplified Specification Version 3.01*
- *SDIO Simplified Specification Version 2.00—SD Specifications Part E1 SDIO Simplified Specification Version 2.00*

Document Revision History

Table 11-29 shows the revision history for this document.

Table 11-29. Document Revision History

Date	Version	Changes
November 2012	1.1	<ul style="list-style-type: none">■ Added programming model section.■ Reorganized programming information.■ Added information about ECCs.■ Added pin listing.■ Updated clocks section.
January 2012	1.0	Initial release

The hardware processor system (HPS) provides a quad serial peripheral interface (SPI) flash controller for access to serial NOR flash devices. The quad SPI flash controller supports standard SPI flash devices as well as high-performance dual and quad SPI flash devices. The quad SPI flash controller is based on Cadence® Quad SPI Flash Controller (QSPI_FLASH_CTRL).

Features of the Quad SPI Flash Controller

The quad SPI flash controller supports the following features:

- Single, dual, and quad I/O commands
- Device frequencies up to 108 MHz
- Direct access and indirect access modes
- External direct memory access (DMA) controller support for indirect transfers
- Configurable polarity, phase, and delay
- Programmable write-protected regions
- Local buffering with error correction code (ECC) logic for indirect transfers
- Up to four devices
- eXecute-In-Place (XIP) flash devices

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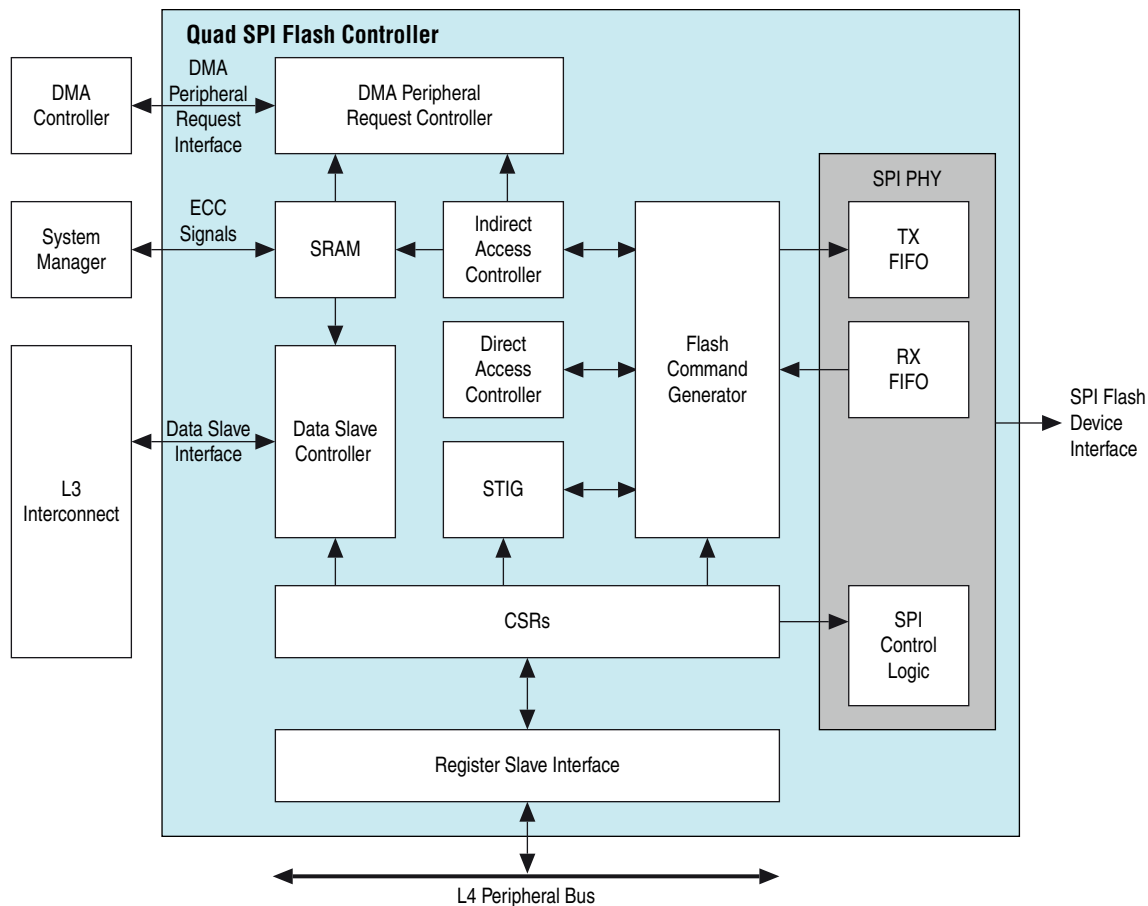
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Quad SPI Flash Controller Block Diagram and System Integration

Figure 12-1 shows the quad SPI flash controller block diagram.

Figure 12-1. Quad SPI Flash Controller Block Diagram



The quad SPI controller consists of the following blocks and interfaces:

- Register slave interface—Slave interface that provides access to the control and status registers (CSRs)
- Data slave controller—Slave interface and controller that provides the following functionality:
 - Performs data transfers to and from the level 3 (L3) interconnect
 - Validates incoming accesses
 - Performs byte or half-word reordering
 - Performs write protection
 - Forwards transfer requests to direct and indirect controller
- Direct access controller—provides memory-mapped slaves direct access to the flash memory

- Indirect access controller—provides higher-performance access to the flash memory through local buffering and software transfer requests
- Software triggered instruction generator (STIG)—generates flash commands through the flash command register (`flashcmd`) and provides low-level access to flash memory
- Flash command generator—generates flash command and address instructions based on instructions from the direct and indirect access controllers or the STIG
- DMA peripheral request controller—issues requests to the DMA peripheral request interface to communicate with the external DMA controller
- SPI PHY—serially transfers data and commands to the external SPI flash devices

Functional Description of the Quad SPI Flash Controller

This section describes the functions of the quad SPI flash controller.

Overview



Terms used in this section are defined in detail in the sections that follow.

The quad SPI flash controller uses the register slave interface to select the operation modes and configure the data slave interface for data transfers. The quad SPI flash controller uses the data slave interface for direct and indirect accesses, and the register slave interface for STIG operation and SPI legacy mode accesses.

Accesses to the data slave are forwarded to the direct or indirect access controller. If the access address is within the configured indirect address range, the access is sent to the indirect access controller.

Data Slave Interface

The quad SPI flash controller uses the data slave interface for direct, indirect, and SPI legacy mode accesses. For information about these modes, refer to the following sections.

The data slave is 32 bits wide. Byte, half-word, and word accesses are permitted.

For write accesses, only incrementing bursts are supported, and only of sizes 1, 4, 8, and 16 transfers. For read accesses, all burst types and sizes are supported.

Register Slave Interface

The quad SPI flash controller uses the register slave interface to configure the quad SPI controller through the quad SPI configuration registers, and to access flash memory under software control, through the `flashcmd` register in the STIG.

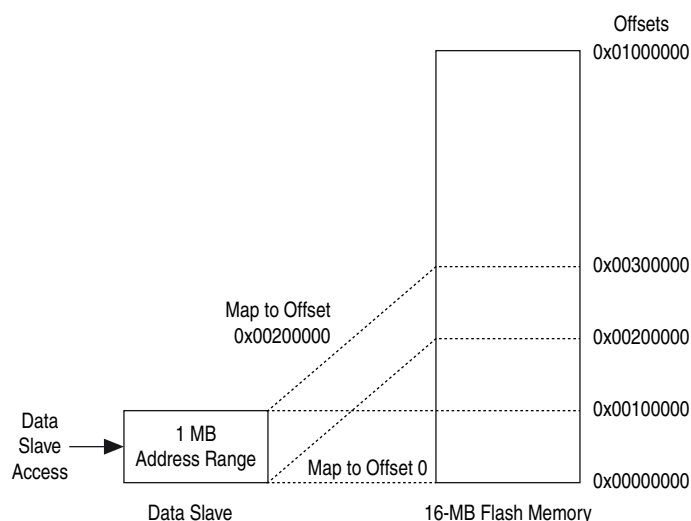
Direct Access Mode

In direct access mode, an access to the data slave triggers a read or write command to the flash memory. To use the direct access mode, enable the direct access controller with the enable direct access controller bit (`endiracc`) of the quad SPI configuration register (`cfg`).

An external master, for example a processor, triggers the direct access controller with a read or write operation to the data slave interface. The data slave exposes a 1 MB window into the flash device. You can remap this window to any 1 MB location within the flash device.

Figure 12-2 shows an example remapping.

Figure 12-2. Data Slave Remapping Example



To remap the data slave to access other 1 MB regions of the flash device, enable address remapping in the enable AHB address remapping field (`enahbremap`) of the `cfg` register. All incoming data slave accesses remap to the offset specified in the remap address register (`remapaddr`).

The 20 LSBs of incoming addresses are used for accessing the 1 MB region and the higher bits are ignored.



The quad SPI controller does not issue any error status for accesses that lie outside the connected flash memory space.

Indirect Access Mode

In indirect access mode, flash data is temporarily buffered in the quad SPI controller's SRAM. Software controls and triggers indirect accesses through the register slave interface. The controller transfers data through the data slave interface.

Indirect Read Operation

An indirect read operation reads data from the flash memory, places the data into the SRAM, and transfers the data to an external master through the data slave interface. The indirect read operations are controlled by the following registers:

- Indirect read transfer register (`indr`)
- Indirect read transfer watermark register (`indrwater`)
- Indirect read transfer start address register (`indrstaddr`)
- Indirect read transfer number bytes register (`indrcont`)
- Indirect address trigger register (`indrtrig`)

These registers need to be configured prior to issuing indirect read operations. The start address needs to be defined in the `indrstaddr` register and the total number of bytes to be fetched is specified in the `indrcont` register. Writing 1 to the start indirect read bit (`start`) of the `indr` register triggers the indirect read operation from the flash memory to populate the SRAM with the returned data.

To read data from the flash device into the SRAM, an external master issues 32-bit read transactions to the data slave interface. The address of the read access must be in the indirect address range. You can configure the indirect address through the `indrtrig` register. The external master can issue 32-bit reads until the last word of an indirect transfer. On the final read, the external master may issue a 32-bit, 16-bit or 8-bit read to complete the transfer. If there are less than four bytes of data to read on the last transfer, the external master can still issue a 32-bit read and the quad SPI controller will pad the upper bits of the response data with zeros.

Assuming the requested data is present in the SRAM at the time the data slave read is received by the quad SPI controller, the data is fetched from SRAM and the response to the read burst is achieved with minimum latency. If the requested data is not immediately present in the SRAM, the data slave interface enters a wait state until the data has been read from flash memory into SRAM. Once the data has been read from SRAM by the external master, the quad SPI controller frees up the associated resource in the SRAM. If the SRAM is full, reads on the SPI interface are backpressured until space is available in the SRAM. The quad SPI controller completes any current read burst, waits for SRAM to free up, and issues a new read burst at the address where the previous burst was terminated.

The processor can also use the SRAM fill level in the SRAM fill register (`sramfill`) to control when data should be fetched from the SRAM.

Another alternative is to use the fill level watermark of the SRAM, which you configure in the `indrwater` register. When the SRAM fill level passes the watermark level, the indirect transfer watermark interrupt is generated. You can disable the watermark feature by writing zero to the `indrwater` register.

For the final bytes of data read by the quad SPI controller and placed in the SRAM, if the watermark level is greater than zero, the indirect transfer watermark interrupt is generated even when the actual SRAM fill level has not risen above the watermark.

If the address of the read access is outside the range of the indirect trigger address, one of the following actions occurs:

- When direct access mode is enabled, the read uses direct access mode.

- When direct access mode is disabled, the slave returns an error back to the requesting master.

You can cancel an indirect operation by setting the cancel indirect read bit (`cancel`) of the `indr` register to 1. For more information, refer to [“Indirect Read Operation” on page 12-15](#).

Indirect Write Operation

An indirect write operation programs data from the SRAM to the flash memory. The indirect write operations are controlled by the following registers:

- Indirect write transfer register (`indwr`)
- Indirect write transfer watermark register (`indwrwater`)
- Indirect write transfer start address register (`indwrstaddr`)
- Indirect write transfer number bytes register (`indwrcnt`)
- `indaddrtrig` register

These registers need to be configured prior to issuing indirect write operations. The start address needs to be defined in the `indwrstaddr` register and the total number of bytes to be written is specified in the `indwrcnt` register. The start indirect write bit (`start`) of the `indwr` register triggers the indirect write operation from the SRAM to the flash memory.

To write data from the SRAM to the flash device, an external master issues 32-bit write transactions to the data slave. The address of the write access must be in the indirect address range. You can configure the indirect address through the `indaddrtrig` register. The external master can issue 32-bit writes until the last word of an indirect transfer. On the final write, the external master may issue a 32-bit, 16-bit or 8-bit write to complete the transfer. If there are less than four bytes of data to write on the last transfer, the external master can still issue a 32-bit write and the quad SPI controller discards the extra bytes.

The SRAM size can limit the amount of data that the quad SPI controller can accept from the external master. If the SRAM is not full at the point of the write access, the data is pushed to the SRAM with minimum latency. If the external master attempts to push more data to the SRAM than the SRAM can accept, the quad SPI controller backpressures the external master with wait states. When the SRAM resource is freed up by pushing the data from SRAM to the flash memory, the SRAM is ready to receive more data from the external master. When the SRAM holds an equal or greater number of bytes than the size of a flash page, or when the SRAM holds all the remaining bytes of the current indirect transfer, the quad SPI controller initiates a write operation to the flash memory.

The processor can also use the SRAM fill level, in the `sramfill` register, to control when to write more data into the SRAM.

Alternatively, you can configure the fill level watermark of the SRAM in the `indwrwater` register. When the SRAM fill level falls below the watermark level, an indirect transfer watermark interrupt is generated to tell software to write the next page of data to SRAM. Because the quad SPI controller initiates non-end-of-data writes to the flash memory only when the SRAM contains a full flash page of data, you must set the watermark level to a value greater than one flash page to avoid the system stalling. You can disable the watermark feature by writing zero to the `indwrwater` register.

If the address of the write access is outside the range of the indirect trigger address, one of the following actions occurs:

- When direct access mode is enabled, the write uses direct access mode.
- When direct access mode is disabled, the slave returns an error back to the requesting master.

You can cancel an indirect operation by setting the cancel indirect write bit (`cancel`) of the `indwr` register to 1.

For more information, refer to [“Indirect Write Operation” on page 12-16](#).

Consecutive Reads and Writes

It is possible to trigger two indirect operations at a time by triggering the start bit of the `indr` or `indwr` register twice in short succession. The second operation can be triggered while the first operation is in progress. For example, software may trigger an indirect read or write operation while an indirect write operation is in progress. The corresponding start and count registers must be configured properly before software triggers each transfer operation.

This approach allows for a short turnaround time between the completion of one indirect operation and the start of a second operation. Any attempt to queue more than two operations causes the indirect read reject interrupt to be generated.

Local Memory Buffer

The SRAM local memory buffer is a 128 by 32-bit (512 total bytes) memory and includes support for ECC. The ECC logic provides outputs to notify the system manager when single-bit correctable errors are detected (and corrected) and when double-bit uncorrectable errors are detected. The ECC logic also allows the injection of single- and double-bit errors for test purposes.



For more information, refer to the [System Manager](#) chapter in volume 3 of the *Cyclone V Device Handbook*.

The SRAM has two partitions, with the lower partition reserved for indirect read operations and the upper partition for indirect write operations. The size of the partitions is specified in the SRAM partition register (`srampart`), based on 32-bit word sizes. For example, to specify four bytes of storage, write the value 1. The value written to the indirect read partition size field (`addr`) defines the number of entries reserved for indirect read operations. For example, write the value 32 (0x20) to partition the 128-entry SRAM to 32 entries (25%) for read usage and 96 entries (75%) for write usage.

DMA Peripheral Request Controller

The DMA peripheral request controller is only used for the indirect mode of operation where data is temporarily stored in the SRAM. The quad SPI flash controller uses the DMA peripheral request interface to trigger the external DMA into performing data transfers between memory and the quad SPI controller.

There are two DMA peripheral request interfaces, one for indirect reads and one for indirect writes. The DMA peripheral request controller can issue two types of DMA requests, single or burst, to the external DMA. The number of bytes for each single or burst request is specified in the number of single bytes (`numsglreqbytes`) and number of burst bytes (`numburstreqbytes`) fields of the DMA peripheral register (`dmaper`). The DMA peripheral request controller splits the total amount of data to be transferred into a number of DMA burst and single requests by dividing the total number of bytes by the number of bytes specified in the burst request, and then dividing the remainder by the number of bytes in a single request.



When programming the DMA controller, the burst request size must match the burst request size set in the quad SPI controller to avoid quickly reaching an overflow or underflow condition.

For indirect reads, the DMA peripheral request controller only issues DMA requests after the data has been retrieved from flash memory and written to SRAM. The rate at which DMA requests are issued depends on the watermark level. The `indrwater` register defines the minimum fill level in bytes at which the DMA peripheral request controller can issue the DMA request. The higher this number is, the more data that must be buffered in SRAM before the external DMA moves the data. When the SRAM fill level passes the watermark level, the transfer watermark reached interrupt is generated.

For example, consider the following conditions:

- The total amount of data to be read using indirect mode is 256 bytes
- The SRAM watermark level is set at 128 bytes
- Software configures the burst type transfer size to 64 bytes

Under these conditions, the DMA peripheral request controller issues the first DMA burst request when the SRAM fill level passes 128 bytes (the watermark level). The DMA peripheral request controller triggers consecutive DMA burst requests as long as there is sufficient data in the SRAM to perform burst type requests. In this example, DMA peripheral request controller can issue at least two consecutive DMA burst requests to transfer a total of 128 bytes. If there is sufficient data in the SRAM, the DMA peripheral request controller requests the third DMA burst immediately.

Otherwise the DMA peripheral request controller waits for the SRAM fill level to pass the watermark level again to trigger the next burst request. When the watermark level is triggered, there is sufficient data in the SRAM to perform the third and fourth burst requests to complete the entire transaction.

For the indirect writes, the DMA peripheral request controller issues DMA requests immediately after the transfer is triggered and continues to do so until the entire indirect write transfer has been transferred. The rate at which DMA requests are issued depends on the watermark level. The `indwrwater` register defines the maximum fill level in bytes at which the controller can issue the first DMA burst or single request. When the SRAM fill level falls below the watermark level, the transfer watermark reached interrupt is generated. When there is one flash page of data in the SRAM, the quad SPI controller initiates the write operation from SRAM to the flash memory.

Software can disable the DMA peripheral request interface with the `endma` field of the `cfg` register. If a master other than the DMA performs the data transfer for indirect operations, the DMA peripheral request interface must be disabled. By default, the indirect watermark registers are set to zero, which means the DMA peripheral request controller can issue DMA request as soon as possible.



For more information about the HPS DMA controller, refer to the [DMA Controller](#) chapter in volume 3 of the *Cyclone V Device Handbook*.

STIG Operation

The STIG provides software a method to access the flash device registers directly. The `flashcmd` register uses the following parameters to define the command to be issued to the flash device:

- Instruction opcode
- Number of address bytes
- Number of dummy bytes
- Number of write data bytes
- Write data
- Number of read data bytes

The address is specified through the flash command address register (`flashcmdaddr`). Once these settings have been specified, software can trigger the command with the execute command field (`execcmd`) of the `flashcmd` register and wait for its completion by polling the command execution status bit (`cmdexecstat`) of the `flashcmd` register. A maximum of eight data bytes may be read from the flash command read data lower (`flashcmdrddatalo`) and flash command read data upper (`flashcmdrddataup`) registers or written to the flash command write data lower (`flashcmdwrdatao`) and flash command write data upper (`flashcmdwrdataup`) registers per command.

Commands issued through the STIG have a higher priority than all other read accesses and therefore interrupt any read commands being requested by the direct or indirect controllers. However, the STIG does not interrupt a write sequence that may have been issued through the direct or indirect access controller. In these cases, it might take a long time for the `cmdexecstat` bit of the `flashcmd` register indicates the operation is complete.



Altera recommends using the STIG instead of the SPI legacy mode to access the flash device registers and perform erase operations.

SPI Legacy Mode

SPI legacy mode allows software to access the internal TX FIFO and RX FIFO buffers directly, thus bypassing the direct, indirect and STIG controllers. Software accesses the TX FIFO and RX FIFO buffers by writing any value to any address through the data slave while legacy mode is enabled. You can enable legacy mode with the legacy IP mode enable bit (`enlegacyip`) of the `cfg` register.

Legacy mode allows the user to issue any flash instruction to the flash device, but imposes a heavy software overhead in order to manage the fill levels of the FIFO buffers effectively. The legacy SPI mode is bidirectional in nature, with data continuously being transferred both directions while the chip select is enabled. If the driver only needs to read data from the flash device, dummy data must be written to ensure the chip select stays active, and vice versa for write transactions.

For example, to perform a basic read of four bytes to a flash device that has three address bytes, software must write a total of eight bytes to the TX FIFO buffer. The first byte would be the instruction opcode, the next three bytes are the address, and the final four bytes would be dummy data to ensure the chip select stays active while the read data is returned. Similarly, because eight bytes were written to the TX FIFO buffer, software should expect eight bytes to be returned in the RX FIFO buffer. The first four bytes of this would be discarded, leaving the final four bytes holding the data read from the device.

Because the TX FIFO and RX FIFO buffers are four bytes deep each, software must maintain the FIFO buffer levels to ensure the TX FIFO buffer does not underflow and the RX FIFO buffer does not overflow. Interrupts are provided to indicate when the fill levels pass the watermark levels, which are configurable through the TX threshold register (`txtresh`) and RX threshold register (`rxtrsh`).

Configuring the Flash Device

For read and write accesses, software must initialize the device read instruction register (`devrd`) and the device write instruction register (`devwr`). These registers include fields to initialize the instruction opcodes that should be used as well as the instruction type, and whether the instruction uses single, dual or quad pins for address and data transfer. To ensure the quad SPI controller can operate from a reset state, the opcode registers reset to opcodes compatible with single I/O flash devices.

The quad SPI flash controller uses the instruction transfer width field (`instwidth`) of the `devrd` register to set the instruction transfer width for both reads and writes. There is no `instwidth` field in the `devwr` register. If instruction type is set to dual or quad mode, the address transfer width (`addrwidth`) and data transfer width (`datawidth`) fields of both registers are redundant because the address and data type is based on the instruction type. Thus, software can support the less common flash instructions where the opcode, address, and data are sent on two or four lanes. For most

instructions, the opcodes are sent serially to the flash device, even for dual and quad instructions. One of the flash devices that supports instructions that can send the opcode over two or four lanes is the Micron N25Q128. For reference, [Table 12-1](#) shows how software should configure the quad SPI controller for each specific read and write instruction supported by the Micron N25Q128 device.

Table 12-1. Quad SPI Configuration for Micron N25Q128 Device

Instruction	Lanes Used By Opcode	Lanes Used to Send Address	Lanes Used to Send Data	instwidth Value	addrwidth Value	datawidth Value
Read Instructions						
Read	1	1	1	0	0	0
Fast read	1	1	1	0	0	0
Dual output fast read (DOFR)	1	1	2	0	0	1
Dual I/O fast read (DIOFR)	1	2	2	0	1	1
Quad output fast read (QOFR)	1	1	4	0	0	2
Quad I/O fast read (QIOFR)	1	4	4	0	2	2
Dual command fast read (DCFR)	2	2	2	1	Don't care	Don't care
Quad command fast read (QCFR)	4	4	4	2	Don't care	Don't care
Write Instructions						
Page program	1	1	1	0	0	0
Dual input fast program (DIFP)	1	1	2	0	0	1
Dual input extended fast program (DIEFP)	1	2	2	0	1	1
Quad input fast program (QIFP)	1	1	4	0	0	2
Quad input extended fast program (QIEFP)	1	4	4	0	2	2
Dual command fast program (DCFP)	2	2	2	1	Don't care	Don't care
Quad command fast program (QCFP)	4	4	4	2	Don't care	Don't care

XIP Mode

The quad SPI controller supports XIP mode, if the flash devices support XIP mode. Depending on the flash device, XIP mode puts the flash device in read-only mode, reducing command overhead.

The quad SPI controller must instruct the flash device to enter XIP mode by sending the mode bits. When the enter XIP mode on next read bit (`enterxipnextrd`) of the `cfg` register is set to 1, the quad SPI controller and the flash device are ready to enter XIP mode on the next read instruction. When the enter XIP mode immediately bit (`enterxipimm`) of the `cfg` register is set to 1, the quad SPI controller and flash device enter XIP mode immediately.

When the `enterxipnextrd` or `enterxipimm` bit of the `cfg` register is set to 0, the quad SPI controller and flash device exit XIP mode on the next read instruction.

For more information, refer to [“XIP Mode Operations” on page 12-17](#).

Write Protection

You can program the controller to write protect a specific region of the flash device. The protected region is defined as a set of blocks, specified by a starting and ending block. Writing to an area of protected flash region memory generates an error and triggers an interrupt.

You define the block size by specifying the number of bytes per block through the number of bytes per block field (`bytespersubsector`) of the device size register (`devsz`). The lower write protection register (`lowwrprot`) specifies the first flash block in the protected region. The upper write protection register (`uppwrt`) specifies the last flash block in the protected region.

The write protection enable bit (`en`) of the write protection register (`wrprot`) enables and disables write protection. The write protection inversion bit (`inv`) of the `wrprot` register flips the definition of protection so that the region specified by `lowwrprt` and `uppwrt` is unprotected and all flash memory outside that region is protected.

Data Slave Sequential Access Detection

The quad SPI flash controller detects sequential accesses to the data slave interface by comparing the current access with the previous access. An access is sequential when it meets the following conditions:

- The address of the current access sequentially follows the address of the previous access.
- The direction of the current access (read or write) is the same as previous access.
- The size of the current access (byte, half-word, or word) is the same as previous access.

When the access is detected as nonsequential, the sequential access to the flash device is terminated and a new sequential access begins. Altera recommends accessing the data slave sequentially. Sequential access has less command overhead, and therefore, increases data throughput.

Clocks

There are two clock inputs to the quad SPI controller (`l4_mp_clk` and `qspi_clk`) and one clock output (`sclk_out`). The quad SPI flash controller uses the `l4_mp_clk` clock to clock the data slave transfers and register slave accesses. The `qspi_clk` clock is the reference clock for the quad SPI controller and is used to serialize the data and drive the external SPI interface. The `sclk_out` clock is the clock source for the connected flash devices.

The `qspi_clk` clock must be greater than two times the `l4_mp_clk`. The `sclk_out` clock is derived by dividing down the `qspi_clk` clock by the baud rate divisor field (`bauddiv`) of the `cfg` register.



For more information, refer to the *Clock Manager* chapter in volume 3 of the *Cyclone V Device Handbook*.

Resets

A single reset signal (`qspi_flash_rst_n`) is provided as an input to the quad SPI controller. The reset manager drives the signal on a cold or warm reset.



For more information, refer to the *Reset Manager* chapter in volume 3 of the *Cyclone V Device Handbook*.

Interrupts

All interrupt sources are combined to create a single level-sensitive, active-high interrupt (`qspi_intr_in`). Software can determine the source of the interrupt by reading the interrupt status register (`irqstat`). By default, the interrupt source is cleared when software writes the interrupt status register. The interrupts are individually maskable through the interrupt mask register (`irqmask`). Table 12-2 lists the interrupt sources in the `irqstat` register.

Table 12-2. Interrupt Sources in the `irqstat` Register

Interrupt Source	Description
Underflow detected	When 0, no underflow has been detected. When 1, the data slave write data is being supplied too slowly. This situation can occur when data slave write data is being supplied too slowly to keep up with the requested write operation. This bit is reset only by a system reset and cleared to zero only when the register is written to.
Indirect operation complete	The controller has completed a triggered indirect operation.
Indirect read reject	An indirect operation was requested but could not be accepted because two indirect operations are already in the queue.
Protected area write attempt	A write to a protected area was attempted and rejected.
Illegal data slave access detected	An illegal data slave access has been detected. Data slave wrapping bursts and the use of split and retry accesses can cause this interrupt. It is usually an indicator that soft masters in the FPGA fabric are attempting to access the HPS in an unsupported way.
Transfer watermark reached	The indirect transfer watermark level has been reached.
Receive overflow	This condition occurs only in legacy SPI mode. When 0, no overflow has been detected. When 1, an overflow to the RX FIFO buffer has occurred. This bit is reset only by a system reset and cleared to zero only when this register is written to. If a new write to the RX FIFO buffer occurs at the same time as a register is read, this flag remains set to 1.
TX FIFO not full	This condition occurs only in legacy SPI mode. When 0, the TX FIFO buffer is full. When 1, the TX FIFO buffer is not full.
TX FIFO full	This condition occurs only in legacy SPI mode. When 0, the TX FIFO buffer is not full. When 1, the TX FIFO buffer is full.
RX FIFO not empty	This condition occurs only in legacy SPI mode. When 0, the RX FIFO buffer is empty. When 1, the RX FIFO buffer is not empty.

Table 12-2. Interrupt Sources in the irqstat Register

Interrupt Source	Description
RX FIFO full	This condition occurs only in legacy SPI mode. When 0, the RX FIFO buffer is not full. When 1, the RX FIFO buffer is full.
Indirect read partition overflow	Indirect Read Partition of SRAM is full and unable to immediately complete indirect operation

Interface Signals

The quad SPI controller provides four chip select outputs to allow control of up to four external quad SPI flash devices. The outputs serve different purposes depending on whether the device is used in single, dual, or quad operation mode. Table 12-3 lists the I/O pin use of the quad SPI controller interface signals for each operation mode.

Table 12-3. Interface Signals

Signal	Mode	Direction	Function
data[0]	Single	Output	Data output 0
	Dual or quad	Bidirectional	Data I/O 0
data[1]	Single	Input	Data input 0
	Dual or quad	Bidirectional	Data I/O 1
data[2]	Single or dual	Output	Active low write protect
	Quad	Bidirectional	Data I/O 2
data[3]	Single, dual, or quad	Bidirectional	Data I/O 3
ss_n[0]	Single, dual, or quad	Output	Active low slave select 0
ss_n[1]			Active low slave select 1
ss_n[2]			Active low slave select 2
ss_n[3]			Active low slave select 3
sclk			Serial clock

Quad SPI Flash Controller Programming Model

This section describes the programming model for the quad SPI controller.

Setting Up the Quad SPI Flash Controller

The following steps describe how to set up the quad SPI controller:

1. Wait until any pending operation has completed.
2. Disable the quad SPI controller with the quad SPI enable field (en) of the cfg register.
3. Update the instwidth field of the devrd register with the instruction type you wish to use for indirect and direct writes and reads.
4. If mode bit enable bit (enmodebits) of the devrd register is enabled, update the mode bit register (modebit).

5. Update the `devsz` register as needed. Parts or all of this register might have been updated after initialization. The number of address bytes is a key configuration setting required for performing reads and writes. The number of bytes per page is required for performing any write. The number of bytes per device block is only required if the write protect feature is used.
6. Update the device delay register (`delay`). This register allows the user to adjust how the chip select is driven after each flash access. Each device may have different timing requirements. If the serial clock frequency is increased, these timing requirements become more critical. The numbers specified in this register are based on the period of the `qspi_clk` clock.

For example, on some devices need 50 ns minimum time before the slave select can be reasserted after it has been deasserted. When the device is operating at 100 MHz, the clock period is 10 ns, so 40 ns extra is required. If the `qspi_clk` clock is running at 400 MHz (2.5 ns period), specify a value of at least 16 to the clock delay for chip select deassert field (`nss`) of the delay register.
7. Update the `remapaddr` register as needed. This register only affects direct access mode.
8. Set up and enable the write protection registers (`wrprot`, `lowwrprot`, and `upwrprot`), when write protection is required.
9. Enable required interrupts through the `irqmask` register.
10. Set up the `bauddiv` field of the `cfg` register to define the required clock frequency of the target device.
11. Update the read data capture register (`rddatacap`) as needed. This register delays when the read data is captured and can help when the read data path from the device to the quad SPI controller is long and the device clock frequency is high.
12. Enable the quad SPI controller with the `en` field of the `cfg` register.

Indirect Read Operation

The following steps describe the general software flow to set up the quad SPI controller for indirect read operation with the DMA disabled:

1. Perform the steps described in [“Setting Up the Quad SPI Flash Controller” on page 12-14](#).
2. Set the flash memory start address in the `indrdstaddr` register.
3. Set the number of bytes to be transferred in the `indrdcnt` register.
4. Set the indirect transfer trigger address in the `indaddrtrig` register.
5. Set up the required interrupts through the `irqmask` register.
6. If the watermark level is used, set the SRAM watermark level through the `indrwater` register.
7. Start the indirect read operation by setting the `start` field of the `indr` register to 1.
8. Either use the watermark level interrupt or poll the SRAM fill level in the `sramfill` register to determine when there is sufficient data in the SRAM.

9. Issue a read transaction to the indirect address to access the SRAM. Repeat step 8 if more read transactions are needed to complete the indirect read transfer.
10. Either use the indirect complete interrupt to determine when the indirect read operation has completed or poll the completion status of the indirect read operation through the indirect completion status bit (`ind_ops_done_status`) of the `indr` register.

The following steps describe the general software flow to set up the quad SPI controller for indirect read operation with the DMA enabled:

1. Perform the steps described in [“Setting Up the Quad SPI Flash Controller” on page 12-14](#).
2. Set the flash memory start address in the `indrstaddr` register.
3. Set the number of bytes to be transferred in the `indrcnt` register.
4. Set the indirect transfer trigger address in the `indaddrtrig` register.
5. Set the number of bytes for single and burst type DMA transfers in the `dmaper` register.
6. Optionally set the SRAM watermark level in the `indrwater` register to control the rate DMA requests are issued.
7. Start an indirect read access by setting the `start` field of the `indr` register to 1.
8. Either use the indirect complete interrupt to determine when the indirect read operation has completed or poll the completion status of the indirect read operation through the `ind_ops_done_status` field of the `indr` register.

Indirect Write Operation

The following steps describe the general software flow to set up the quad SPI controller for indirect write operation with the DMA disabled:

1. Perform the steps described in [“Setting Up the Quad SPI Flash Controller” on page 12-14](#).
2. Set the flash memory start address in the `indwrstaddr` register.
3. Set up the number of bytes to be transferred in the `indwrcnt` register.
4. Set the indirect transfer trigger address in the `indaddrtrig` register.
5. Set up the required interrupts through the interrupt mask register (`irqmask`).
6. Optionally set the SRAM watermark level in the `indwrwater` register to control the rate DMA requests are issued. The value set must be greater than one flash page. For more information, refer to [“Indirect Write Operation” on page 12-6](#).
7. Start the indirect write operation by setting the `start` field of the `indwr` register to 1.
8. Either use the watermark level interrupt or poll the SRAM fill level in the `sramfill` register to determine when there is sufficient space in the SRAM.
9. Issue a write transaction to the indirect address to write one flash page of data to the SRAM. Repeat step 8 if more write transactions are needed to complete the indirect write transfer. The final write may be less than one page of data.

The following steps describe the general software flow to set up the quad SPI controller for indirect write operation with the DMA enabled:

1. Perform the steps described in [“Setting Up the Quad SPI Flash Controller” on page 12-14](#).
2. Set the flash memory start address in the `indwrstaddr` register.
3. Set the number of bytes to be transferred in the `indcnt` field of the `indwr` register.
4. Set the indirect transfer trigger address in the `indaddrtrig` register.
5. Set the number of bytes for single and burst type DMA transfers in the `dmaper` register.
6. Optionally set the SRAM watermark level in the `indwrwater` register to control the rate DMA requests are issued. The value set must be greater than one flash page. For more information, refer to [“Indirect Write Operation” on page 12-6](#).
7. Start the indirect write access by setting the `start` field of the `indirwr` register to 1.
8. Either use the indirect complete interrupt to determine when the indirect write operation has completed or poll the completion status of the indirect write operation through the `ind_ops_done_status` field of the `indwr` register.

XIP Mode Operations

This section describes entering and exiting XIP mode. XIP mode is supported in most SPI flash devices. However, flash device manufacturers do not use a consistent standard approach. Most use signature bits that are sent to the device immediately following the address bytes. Some devices use signature bits and also require a flash device configuration register write to enable XIP mode.

Entering XIP Mode

The following sections describe the software steps to enter XIP mode for various types of flash devices.

Micron Quad SPI Flash Devices with Support for Basic-XIP

To enter XIP mode in a Micron quad SPI flash device with support for Basic-XIP, perform the following steps:

1. Save the values in the mode bits, if you intend to restore them upon exit.
2. Disable the direct access controller and indirect access controller to ensure no new read or write accesses are sent to the flash device.
3. Set the XIP mode bits in the `modebit` register to 0x80.
4. Enable the quad SPI controller's XIP mode by setting the `enterxipnextrd` bit of the `cfg` register to 1.
5. Re-enable the direct access controller and, if required, the indirect access controller.

Micron Quad SPI Flash Devices without Support for Basic-XIP

To enter XIP mode in a Micron quad SPI flash device without support for Basic-XIP, perform the following steps:

1. Save the values in the mode bits, if you intend to restore them upon exit.

2. Disable the direct access controller and indirect access controller to ensure no new read or write accesses will be sent to the flash device.
3. Ensure XIP mode is enabled in the flash device by setting the volatile configuration register (VCR) bit 3 to 1. Use the `flashcmd` register to issue the VCR write command.
4. Set the XIP mode bits in the `modebit` register to 0x00.
5. Enable the quad SPI controller's XIP mode by setting the `enterxipnextd` bit of the `cfg` register to 1.
6. Re-enable the direct access controller and, if required, the indirect access controller.

Winbond Quad SPI Flash Devices

To enter XIP mode in a Winbond quad SPI flash device, perform the following steps:

1. Save the values in the mode bits, if you intend to restore them upon exit.
2. Disable the direct access controller and indirect access controller to ensure no new read or write accesses are sent to the flash device.
3. Set the XIP mode bits in the `modebit` register to 0x20.
4. Enable the quad SPI controller's XIP mode by setting the `enterxipnextd` bit of the `cfg` register to 1.
5. Re-enable the direct access controller and, if required, the indirect access controller.

Spansion Quad SPI Flash Devices

To enter XIP mode a Spansion quad SPI flash device, perform the following steps:

1. Save the values in the mode bits, if you intend to restore them upon exit.
2. Disable the direct access controller and indirect access controller to ensure no new read or write accesses are sent to the flash device.
3. Set the XIP mode bits in the `modebit` register to 0xA0.
4. Enable the quad SPI controller's XIP mode by setting the `enterxipnextd` bit of the `cfg` register to 1.
5. Re-enable the direct access controller and, if required, the indirect access controller.

Exiting XIP Mode

To exit XIP mode, perform the following steps:

1. Disable the direct access controller and indirect access controller to ensure no new read or write accesses are sent to the flash device.
2. Restore the mode bits to the values before entering XIP mode, depending on the flash device and manufacturer.
3. Set the `enterxipnextd` bit of the `cfg` register to 0.


The flash device must receive a read instruction before it can disable its internal XIP mode state. Thus, XIP mode internally stays active until the next read instruction is serviced. Ensure that XIP mode is disabled before the end of any read sequence.

XIP Mode at Power on Reset

Some flash devices can be XIP-enabled as a nonvolatile configuration setting, allowing the flash device to enter XIP mode at power-on reset (POR) without software intervention. Software cannot discover the XIP state at POR through flash status register reads because an XIP-enabled flash device can only be accessed through the XIP read operation. If you know the device will enter XIP mode at POR, have your initial boot software configure the `modebit` register and set the `enterxipimm` bit of the `cfg` register to 1.

If you do not know in advance whether or not the device will enter XIP mode at POR, have your initial boot software issue an XIP mode exit command through the `flashcmd` register, then follow the steps in “[Entering XIP Mode](#)” on page 12-17. Software must be aware of the mode bit requirements of the device, because XIP mode entry and exit varies by device.


Quad SPI Flash Controller Address Map and Register Definitions

 The address map and register definitions reside in the [hps.html](#) file that accompanies this handbook volume. Click the link to open the file.

To view the module description and base address, scroll to and click the following links for the module instance:

- [qspiregs](#)
- [qspidata](#)

To then view the register and field descriptions, scroll to and click the register names. The register addresses are offsets relative to the base address of each module instance.

 The base addresses of all modules are also listed in the [Introduction to the Hard Processor System](#) chapter in volume 3 of the *Cyclone V Device Handbook*.

Document Revision History

[Table 12-4](#) shows the revision history for this document.

Table 12-4. Document Revision History

Date	Version	Changes
November 2012	1.2	Minor updates.
May 2012	1.1	Added block diagram and system integration, functional description, programming model, and address map and register definitions sections.
January 2012	1.0	Initial release.

This section includes the following chapters:

- Chapter 13, FPGA Manager
- Chapter 14, System Manager
- Chapter 15, Scan Manager
- Chapter 16, DMA Controller
- Chapter 17, Ethernet Media Access Controller
- Chapter 18, USB 2.0 OTG Controller
- Chapter 19, SPI Controller
- Chapter 20, I²C Controller
- Chapter 21, UART Controller
- Chapter 22, General-Purpose I/O Interface
- Chapter 23, Timer
- Chapter 24, Watchdog Timer
- Chapter 25, CAN Controller



For information about the revision history for chapters in this section, refer to “Document Revision History” in each individual chapter.

The FPGA manager in the hard processor system (HPS) manages and monitors the FPGA portion of the system on a chip (SoC) FPGA device. The FPGA manager can configure the FPGA fabric from the HPS, monitor the state of the FPGA, and drive or sample signals to or from the FPGA fabric.

Features of the FPGA Manager

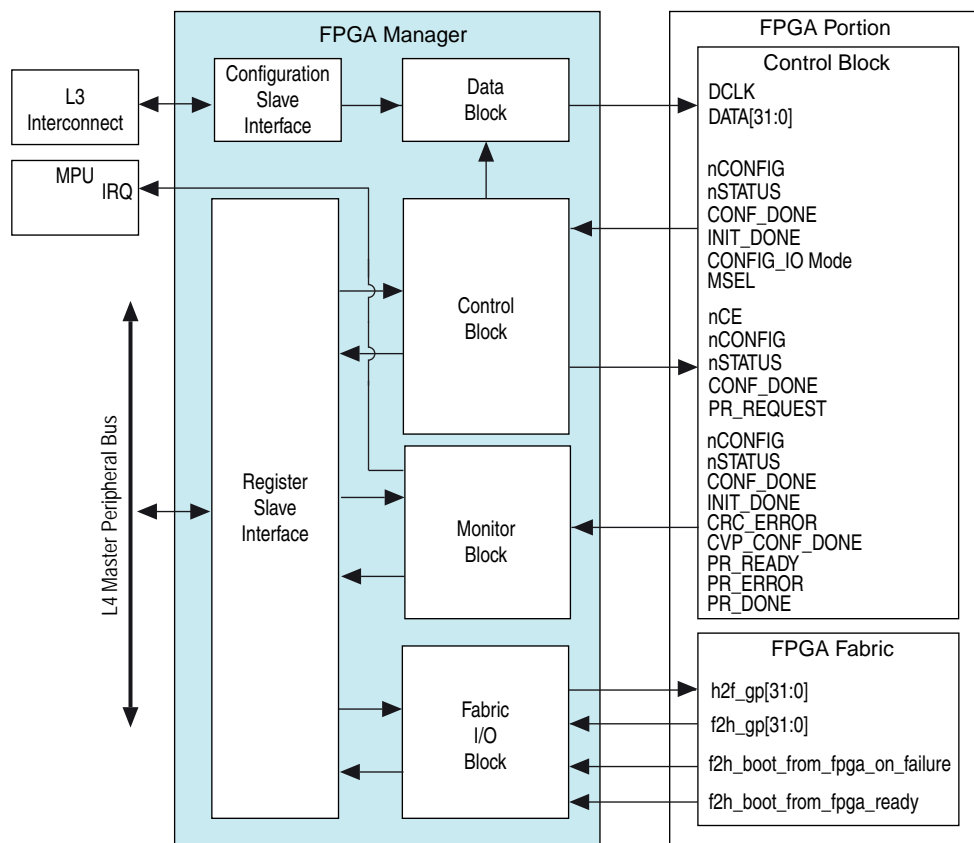
The FPGA manager provides the following functionality and features:

- Full configuration and partial reconfiguration of the FPGA portion of the SoC device
- Drives 32 general-purpose output signals to the FPGA fabric
- Receives 32 general-purpose input signals from the FPGA fabric
- Receives two boot handshaking input signals from the FPGA fabric (used when the HPS boots from the FPGA)
- Monitors the FPGA configuration and power status
- Generates interrupts based on the FPGA status changes
- Can reset the FPGA

FPGA Manager Block Diagram and System Integration

Figure 13-1 shows a block diagram of the FPGA manager.

Figure 13-1. FPGA Manager Block Diagram



The register slave interface connects to the level 4 (L4) master peripheral bus for control and status register (CSR) access. The configuration slave interface connects to the level 3 (L3) interconnect for the microprocessor unit (MPU) subsystem or other masters to write the FPGA configuration image to the FPGA control block (CB) when configuring the FPGA portion of the SoC device.

The general-purpose I/O and boot handshaking input interfaces connect to the FPGA fabric. The FPGA manager also connects to the FPGA CB signals to monitor and control the FPGA portion of the device.

The FPGA manager consists of the following blocks:

- Configuration slave interface—accepts and transfers the configuration image to the data interface.
- Register slave interface—accesses the CSRs in the FPGA manager.
- Data—accepts the FPGA configuration image from the configuration slave interface and sends it to the FPGA CB.
- Control—controls the FPGA CB.

- Monitor—monitors the configuration signals in the FPGA CB and sends interrupts to the MPU subsystem.
- Fabric I/O—reads and writes signals from or to the FPGA fabric.

Functional Description of the FPGA Manager

FPGA Manager Building Blocks

The FPGA manager has the following blocks to monitor the signals coming from the FPGA portion of the device.

Fabric I/O

The fabric I/O block contains the following registers to allow simple low-latency communication between the HPS and the FPGA fabric:

- General-purpose input register (`gpi`)
- General-purpose output register (`gpo`)
- Boot handshaking input register (`misci`)

These registers are only valid when the FPGA is in user mode. Reading from these registers while the FPGA is not in user mode provides undefined data.

The 32 general-purpose input signals from the FPGA fabric are read by reading the `gpi` register using the register slave interface. The 32 general-purpose output signals to the FPGA fabric are generated from writes to the `gpo` register. For more information about FPGA manager registers, refer to [“FPGA Manager Address Map and Register Definitions” on page 13-7](#).

The boot handshaking input signals from the FPGA fabric are read by reading the `misci` register. The `f2h_boot_from_fpga_ready` signal indicates to the boot ROM when logic in the FPGA fabric is ready to accept configuration interface requests from the HPS-to-FPGA bridge when the boot ROM is booting from the FPGA. The `f2h_boot_from_fpga_on_failure` signal serves as a fallback in the event that the boot ROM code fails to boot from the primary boot flash device. In this case, the boot ROM code checks these two handshaking signals to determine if it should use the boot code hosted in the FPGA memory as the next stage in the boot process.

There is no interrupt support for this block.

Monitor

The monitor block is an instance of the Synopsys® DesignWare® GPIO IP (`DW_apb_gpio`), which is a separate instance of the IP that comprises the three HPS GPIO interfaces. The monitor block connects to the configuration signals in the FPGA. This block monitors key signals related to FPGA configuration such as `INIT_DONE`, `CRC_ERROR`, and `PR_DONE`. Software configures the monitor block through the register slave interface, and can either poll FPGA signals or be interrupted. The **mon** address map within the FPGA manager register address map contains the monitor registers. For more information about FPGA manager registers, refer to [“FPGA Manager Address Map and Register Definitions” on page 13-7](#).

You can program the FPGA manager to treat any of the monitor signals as interrupt sources. Independent of the interrupt source type, the monitor block always drives an active-high level interrupt to the MPU. Each interrupt source can be of the following types:

- Active-high level
- Active-low level
- Rising edge
- Falling edge

FPGA Configuration

You can configure the FPGA using an external device or through the HPS. This section only covers configuring the FPGA through the HPS.



For information about configuring the FPGA using an external device, refer to the *Configuration, Design Security, and Remote System Upgrades in Cyclone V Devices* chapter in volume 1 of the *Cyclone V Device Handbook*.

The FPGA CB uses the FPGA mode select (MSEL) pins to determine which configuration scheme to use. The MSEL pins must be tied to the appropriate values for the configuration scheme. Table 13-1 lists supported MSEL values when the FPGA is configured by the HPS.

HPS software sets the clock-to-data ratio field (cdratio) and configuration data width bit (cfgwidth) in the control register (ctrl) to match the MSEL pins. The cdratio field and cfgwidth bit must be set before the start of configuration.

The FPGA manager connects to the configuration logic in the FPGA portion of the device using a mode similar to how external logic (for example, MAX II or an intelligent host) configures the FPGA in fast passive parallel (FPP) mode. FPGA configuration through the HPS supports all the capabilities of FPP mode, including the following items:

- FPGA configuration
- Partial FPGA reconfiguration
- FPGA I/O configuration, followed by PCI Express® (PCIe®) configuration of the remainder of FPGA
- External single event upset (SEU) scrubbing
- Decompression
- Advanced Encryption Standard (AES) encryption
- FPGA DCLK clock used for initialization phase clock



The FPGA manager supports a data width of 32 or 16 bits. When configuring the FPGA fabric from the HPS, Altera recommends that you always set the data width to 32 bits. For partial reconfiguration, the 16-bit data width is the only option.

Table 13–1 lists the supported configuration schemes and their respective MSEL and control register settings when the HPS configures the FPGA.

Table 13–1. Configuration Schemes for FPGA Configuration by the HPS

Configuration Scheme	Compression Feature	Design Security Feature	POR Delay ⁽²⁾	MSEL[4..0] ⁽³⁾	cfgwidth	cdratio	Supports Partial Reconfiguration
FPP ×16	Disabled	AES Disabled	Fast	00000	0	1	Yes
			Standard	00100	0	1	No
	Disabled	AES Enabled	Fast	00001	0	2	Yes
			Standard	00101	0	2	No
	Enabled	Optional ⁽¹⁾	Fast	00010	0	4	Yes
			Standard	00110	0	4	No
FPP ×32	Disabled	AES Disabled	Fast	01000	1	1	No
			Standard	01100	1	1	No
	Disabled	AES Enabled	Fast	01001	1	4	No
			Standard	01101	1	4	No
	Enabled	Optional ⁽¹⁾	Fast	01010	1	8	No
			Standard	01110	1	8	No

Notes to Table 13–1:

- (1) You can select to enable or disable this feature.
- (2) For information about POR delay, refer to the *Configuration, Design Security, and Remote System Upgrades in Cyclone V Devices* chapter in volume 1 of the Cyclone V Device Handbook.
- (3) Other MSEL values are allowed when the FPGA is configured from a non-HPS source. For information, refer to the *Configuration, Design Security, and Remote System Upgrades in Cyclone V Devices* chapter in volume 1 of the Cyclone V Device Handbook.

Configuring the FPGA portion of the SoC device comprises the following phases:

1. Power up phase
2. Reset phase
3. Configuration phase
4. Initialization phase
5. User mode

Power Up Phase

In this phase, the V_{CC} is ramping up and has yet to reach normal levels. This phase completes when the on-chip voltage detector determines that the V_{CC} has reached normal levels.

Reset Phase

The FPGA manager resets the FPGA portion of the SoC device when the FPGA configuration signal ($nCONFIG$) is driven low. The HPS configures the FPGA by writing a 1 to the $nconfigpull$ bit of the $ctrl$ register. This action causes the FPGA portion of the device to reset and perform the following actions:

1. Clear the FPGA configuration RAM bits

2. Tri-state all FPGA user I/O pins
3. Pull the `nSTATUS` and `CONF_DONE` pins low
4. Use the FPGA CB to read the values of the `MSEL` pins to determine the configuration scheme

The `nconfigpull` bit of the `ctrl` register needs to be set to 0 when the FPGA has successfully entered the reset phase. Setting the bit releases the FPGA from the reset phase and transitions to the configuration phase.



You must set the `cdratio` and `cfgwidth` bits of the `ctrl` register appropriately before the FPGA enters the reset phase.

Configuration Phase

To configure the FPGA using the HPS, software sets the `axicfgen` bit of the `ctrl` register to 1. Software then sends configuration data to the FPGA by writing data to the write data register (`data`) in the FPGA manager module configuration data address map. Software polls the `CONF_DONE` pin by reading the `gpio_instatus` register to determine if the FPGA configuration is successful. When configuration is successful, software sets the `axicfgen` bit of the `ctrl` register to 0. The FPGA user I/O pins are still tri-stated in this phase.



For more information about configuring the FPGA through the HPS, refer to the *Booting and Configuration* appendix in volume 3 of the *Cyclone V Device Handbook*.

After successfully completing the configuration phase, the FPGA transitions to the initialization phase. To delay configuring the FPGA, set the `confdonepull` bit of the `ctrl` register to 1.

Initialization Phase

In this phase, the FPGA prepares to enter user mode. The internal oscillator in the FPGA portion of the device is the default clock source for the initialization phase. Alternatively, the configuration image can specify the `CLKUSR` or the `DCLK` pins as the clock source. The alternate clock source controls when the FPGA enters user mode.

If `DCLK` is selected as the clock source, software uses the `DCLK` count (`dclkcnt`) register to drive `DCLK` pulses to the FPGA. Writing to the `cnt` field of the `dclkcnt` register triggers the FPGA manager to generate the specified number of `DCLK` pulses. When all of the `DCLK` pulses have been sent, the `dcntdone` bit of the `DCLK` status (`dclkstat`) register is set to 1. Software polls the `dcntdone` bit to know when all of the `DCLK` pulses have been sent.





Before another write to the `dclkcnt` register, software needs to write a value of 1 to the `dcntdone` bit to clear the done state.

The FPGA user I/O pins are still tri-stated in this phase. When the initialization phase completes, the FPGA releases the optional `INIT_DONE` pin and an external resistor pulls the pin high.

User Mode

The FPGA enters the user mode after exiting the initialization phase. The FPGA user I/O pins are no longer tri-stated in this phase and the configured soft logic in the FPGA becomes active.


The FPGA remains in user mode until the `nCONFIG` pin is driven low. If the `nCONFIG` pin is driven low, the FPGA reenters the reset phase. The internal oscillator is disabled in user mode, but is enabled as soon as the `nCONFIG` pin is driven low.

-  For more information about configuring the FPGA through the HPS, refer to the *Booting and Configuration* appendix in volume 3 of the *Cyclone V Device Handbook*.
-  For more information about configuring the FPGA in general, refer to the *Configuration, Design Security, and Remote System Upgrades in Cyclone V Devices* chapter in volume 1 of the *Cyclone V Device Handbook*.

Clock


The FPGA manager has two clock input signals which are asynchronous to each other. The clock manager generates these two clocks:

- `cfg_clk`—the configuration slave interface clock input and also the `DCLK` output reference for FPGA configuration. Enable this clock in the clock manager only when configuration is active or when the configuration slave interface needs to respond to master requests.
- `l4_mp_clk`—the register slave interface clock.


-  For more information about the clock manager, refer to the *Clock Manager* chapter in volume 3 of the *Cyclone V Device Handbook*.

Reset

The FPGA manager has one reset signal. The reset manager drives this signal to FPGA manager on a cold or warm reset. All distributed reset signals in the FPGA manager are asserted asynchronously at the same time and de-asserted synchronously to their associated clocks.

-  For more information about the reset manager, refer to the *Reset Manager* chapter in volume 3 of the *Cyclone V Device Handbook*.

FPGA Manager Address Map and Register Definitions

-  The address map and register definitions reside in the [hps.html](#) file that accompanies this handbook volume. Click the link to open the file.

To view the module description and base address, scroll to and click the following links for the module instance:

- [fpgamgrregs](#)
- [fpgamgrdata](#)

To then view the register and field descriptions, scroll to and click the register names. The register addresses are offsets relative to the base address of each module instance.



The base addresses of all modules are also listed in the *Introduction to the Hard Processor System* chapter in volume 3 of the *Cyclone V Device Handbook*.

Document Revision History

Table 13-2 shows the revision history for this document.

Table 13-2. Document Revision History

Date	Version	Changes
November 2012	1.3	Minor updates.
June 2012	1.2	Updated the FPGA configuration section.
May 2012	1.1	<ul style="list-style-type: none"> ■ Updated the configuration schemes table. ■ Updated the FPGA configuration section. ■ Added address map and register definitions section.
January 2012	1.0	Initial release.

The system manager in the hard processor system (HPS) contains memory-mapped control and status registers (CSRs) and logic to control system level functions as well as other modules in the HPS.

The system manager connects to the following modules in the HPS:

- Watchdog timers
- Ethernet media access controllers (EMAC0 and EMAC1)
- Direct memory access (DMA) controller
- USB 2.0 On-The-Go (OTG) controllers (USB0 and USB1)
- Controller area network (CAN) controllers
- NAND flash controller
- Secure Digital/MultiMediaCard (SD/MMC) controller
- Quad serial peripheral interface (SPI) flash controller
- Microprocessor unit (MPU) subsystem

Features of the System Manager

Software accesses the CSRs in the system manager to control and monitor various functions in other HPS modules that require external control signals. The system manager connects to these modules to perform the following functions:

- Sends pause signals to pause the watchdog timers when the processors in the MPU subsystem are in debug mode.
- Freezes the I/O pins after the HPS comes out of cold reset and during serial configuration.
- Selects the EMAC level 3 (L3) master signal options.
- Selects the SD/MMC controller clock options and L3 master signal options.
- Selects the NAND flash controller bootstrap options and L3 master signal options.
- Selects USB controller L3 master signal options.
- Selects whether the CAN controller or the FPGA fabric can issue requests to four of the DMA controller peripheral request interfaces.
- Provides control over the DMA security settings when the HPS exits from reset.
- Provides boot source and clock source information that can be read during the boot process.

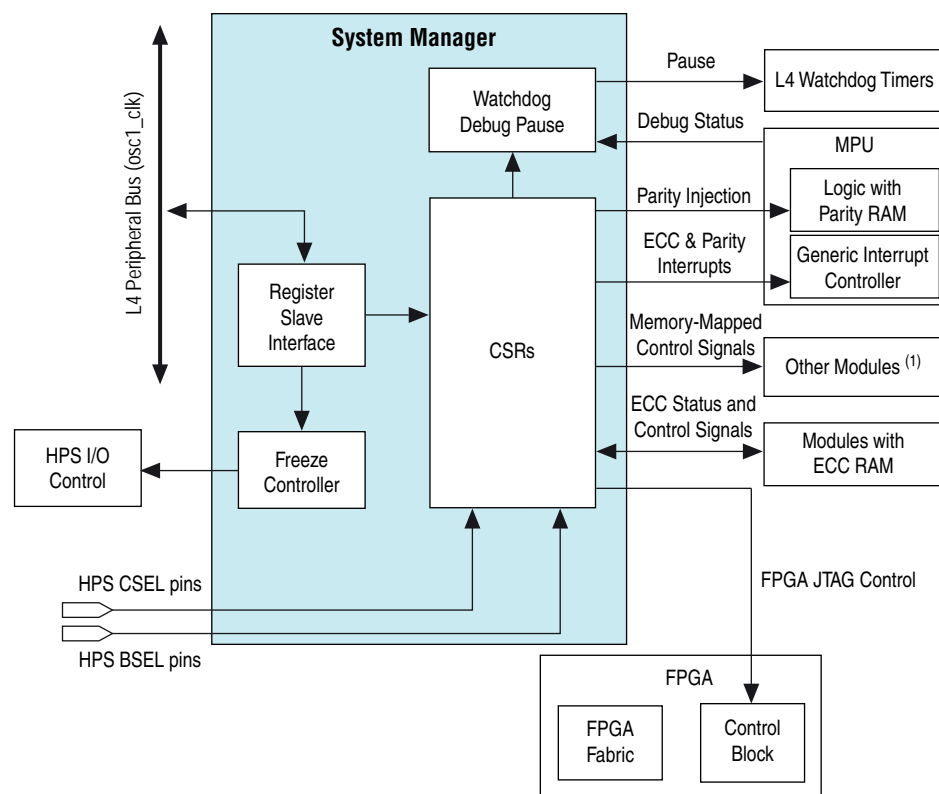
- Sends error correction code (ECC) enable signals to all HPS modules with ECC-protected RAM.
- Provides the capability to inject errors during testing in modules with ECC-protected RAM.
- Controls I/O pin multiplexing in the HPS.
- Provides information about device-specific HPS options such as the number of processor cores and the presence of CAN controllers.
- Triggers parity failures during testing in parity-protected RAMs in the MPU subsystem.
- Allows the HPS to access the FPGA JTAG controller through the scan manager for testing purposes.

System Manager Block Diagram and System Integration

The system manager has a slave interface which connects to the level 4 (L4) bus. The CSRs interface connects to signals in the FPGA and also to other HPS modules.

Figure 14-1 shows a block diagram of the system manager.

Figure 14-1. System Manager Block Diagram



Note to Figure 14-1:

(1) Refer to the list of modules on the following page.

The system manager consists of the following blocks:

- CSRs—provide the following functionality:
 - Provide memory-mapped access to control signals for the following HPS modules:
 - EMACs
 - Debug core
 - Reset manager
 - SD/MMC controller
 - NAND controller
 - SPI masters
 - Quad SPI controller
 - USB controllers
 - DMA controller
 - On-chip RAM
 - CAN controllers
 - Route ECC and parity interrupts to the MPU
 - Store status information received from other HPS modules
 - Controls multiplexing between the FPGA JTAG pins and the scan manager
- Register slave interface—provides connected masters access to the CSRs in the system manager.
- Watchdog debug pause—accepts the debug mode status from the MPU subsystem and pauses the L4 watchdog timers.
- Freeze controller—responsible for placing the HPS I/O pins into a safe state so that they can be configured by software.

Functional Description of the System Manager

This section describes the functional operation of the system manager. The system manager serves the following purposes:

- Provides software access to boot configuration and system information
- Provides software access to control and status signals in other HPS modules
- Enables and controls ECC and parity in HPS modules
- Provides freeze signals to the HPS-configurable I/O pins during configuration
- Enables and disables HPS interfaces
- Controls I/O pin multiplexing
- Provides eight registers that software can use to pass information between boot stages

Boot Configuration and System Information

The system manager provides boot configuration information through the `bootinfo` register. The following information is available to software:

- Sampled value of the HPS boot select (BSEL) pins
- Sampled value of the HPS clock select (CSEL) pins

The boot configuration information comes from the HPS BSEL and CSEL pins. The BSEL signal informs software which flash device CPU0 booted from. The CSEL signal informs software which clock frequency is used for the flash controllers (NAND, SD/MMC, quad SPI).



For boot and clock source values, refer to the *Booting and Configuration* appendix in volume 3 of the *Cyclone V Device Handbook*.

The system manager also provides information about the type of HPS variant available in the system on a chip (SoC) FPGA through the HPS information register (`hpsinfo`) so that software can determine how many processor cores are present and whether the CAN controllers are present in the HPS.

Additional Module Control

Each module in the HPS has its own CSRs, providing access to the internal state of the module. Other modules, as well as logic in the FPGA fabric, can use these CSRs to control and monitor functions in the HPS modules. The system manager CSRs provide access to additional module state information, enabling additional control and monitoring. Therefore, to fully control each module, you must manipulate both the module's own CSRs, and CSRs in the system manager. This section describes system manager CSR usage for each module.

Scan Manager

Either the FPGA JTAG pins or the scan manager can drive JTAG signals to the FPGA. Registers in the system manager control a multiplexer that determines which source drives the JTAG signals to the FPGA. Set the FPGA JTAG enable bit (`fpga_jtagen`) of the control register (`ctrl1`) in the scan manager group (`scanmgrgrp`) to control this selection.



Software running on the HPS must ensure that the FPGA JTAG pins and scan manager's connection to the FPGA control block are inactive before changing the source that drives JTAG signals to the FPGA.



For more information about the scan manager, refer to the *Scan Manager* chapter in volume 3 of the *Cyclone V Device Handbook*.

DMA Controller

There are eight DMA peripheral request interfaces. The FPGA fabric always has access to interfaces 0 to 3. Registers in the system manager control a group of multiplexers that determine whether the FPGA fabric or a CAN controller has access to each of interfaces 4 to 7. [Table 14-1](#) lists how the channel select bits (`chansel[3:0]`) of the control register (`ctrl`) in the DMA controller group (`dmagrp`) control these selections.

Table 14-1. DMA Peripheral Request Interfaces 4 to 7 Usage

Channel Select Bit	Register Value	Usage
0	0	DMA channel 4 connects to the FPGA fabric
	1	DMA channel 4 connects to the CAN0 controller
1	0	DMA channel 5 connects to the FPGA fabric
	1	DMA channel 5 connects to the CAN0 controller
2	0	DMA channel 6 connects to the FPGA fabric
	1	DMA channel 6 connects to the CAN1 controller
3	0	DMA channel 7 connects to the FPGA fabric
	1	DMA channel 7 connects to the CAN1 controller

The security state of the DMA controller is controlled by the manager thread security (`mgrnsecure`) and interrupt security (`irqnsecure`) bits of the `ctrl` register, all in the `dmagrp` group.

The security state of each DMA peripheral request interface is controlled by the peripheral nonsecure bits (`nonsecure[31:0]`) of the peripheral security register (`persecurity`) in the `dmagrp` group. The DMA controller samples these register bits when it is brought out of reset.



Register bits should be accessed only when the DMA master interface is guaranteed to be in an inactive state.



For more information about the DMA controller, refer to the [DMA Controller](#) chapter in volume 3 of the *Cyclone V Device Handbook*.

NAND Flash Controller

Software uses the bootstrap control register (`bootstrap`) in the NAND flash controller group (`nandgrp`) to modify the default behavior of the NAND flash controller after reset. The NAND flash controller samples the register bits when it is brought out of reset.

The following `bootstrap` register bits control configuration of the NAND flash controller:

- Bootstrap inhibit initialization bit (`noinit`)—inhibits the NAND flash controller from performing initialization when coming out of reset, and allows software to program all registers pertaining to device parameters such as page size and width.
- Bootstrap 512 byte device bit (`page512`)—informs the NAND flash controller that a NAND flash device of 512 byte page size is connected to the system.

- Bootstrap inhibit load block 0 page 0 bit (`no_loadb0p0`)—inhibits the NAND flash controller from loading page 0 of block 0 of the NAND flash device as part of the initialization procedure.
- Bootstrap two row address cycles bit (`two_row_addr`)—informs the NAND flash controller that only two ROW address cycles are required instead of the default three row address cycles.

Registers in the system manager control the L3 master ARCACHE and AWCACHE signals. Set the NAND arcache (`arcache[0]`) and NAND awcache (`awcache[0]`) bits of the NAND L3 master AxCACHE register (`l3master`) in the `nandgrp` group to control these selections. These bits define the cache attributes for the master transactions of the DMA engine in the NAND controller.



Register bits should be accessed only when the master interface is guaranteed to be in an inactive state.



For more information about the NAND flash controller, refer to the *NAND Flash Controller* chapter in volume 3 of the *Cyclone V Device Handbook*.

EMAC

The system manager allows software to select either `oscl_clk` or `fpga_ptp_ref_clk` as the source of the IEEE 1588 reference clock for each EMAC. Set the PTP clock select (`ptpclkssel[0]`) and (`ptpclkssel[1]`) bits of the `ctrl` register in the EMAC group (`emacgrp`) to control this selection.



For more information about the reference clock, refer to the *Clock Manager* chapter in volume 3 of the *Cyclone V Device Handbook*.

Registers in the system manager control the L3 master ARCACHE and AWCACHE signals. Set the `arcache[0]`, `arcache[1]`, `awcache[0]`, and `awcache[1]` bits of the EMAC L3 master AxCACHE register (`l3master`) in the `emacgrp` group to control these selections. These bits define the cache attributes for the master transactions of the DMA engine in the EMAC controllers.



Register bits should be accessed only when the master interface is guaranteed to be in an inactive state.





For more information about the EMAC, refer to the *Ethernet Media Access Controller* chapter in volume 3 of the *Cyclone V Device Handbook*.

USB 2.0 OTG Controller

Registers in the system manager control whether the USB 2.0 OTG controller L3 master is used for data or opcode access. Set the USB HPROT data/opcode bits (`hprotdata[0]` and `hprotdata[1]`) of the USB L3 master HPROT register (`l3master`) in the USB controller group (`usbgrp`) to specify the access for each USB controller.

You can also use the system manager to specify whether the USB controller L3 master access is privileged, bufferable, or cacheable for each USB controller by setting the USB HPROT privileged (`hprotpriv[0]` and `hprotdata[1]`), USB HPROT bufferable (`hprotbuff[0]` and `hprotbuff[1]`), and USB HPROT cacheable (`hprotcache[0]` and `hprotcache[1]`) bits of the `l3master` register in the `usbgrp` group.


 Register bits should be accessed only when the master interface is guaranteed to be in an inactive state.

 For more information about the USB 2.0 OTG controller, refer to the [USB 2.0 OTG Controller](#) chapter in volume 3 of the *Cyclone V Device Handbook*.

SD/MMC Controller

Registers in the system manager control whether the SD/MMC controller L3 master is used for data or opcode access. Set the SD/MMC `hprotdata[0]` bit of the SD/MMC `l3master` register in the SD/MMC controller group (`sdmmcgrp`) to specify the access mode.

You can use the system manager to specify whether the SD/MMC controller L3 master access is privileged, bufferable, or cacheable by setting the SD/MMC `hprotpriv[0]`, `hprotbuff[0]`, and `hprotcache[0]` bits of the `l3master` register in the `sdmmcgrp` group.

 Register bits should be accessed only when the master interface is guaranteed to be in an inactive state.

The system manager allows software to select the clock's phase shift for `cclk_in_drv` and `cclk_in_sample` by setting the drive clock phase shift select (`drvsel`) and sample clock phase shift select (`smplsel`) bits of the `ctrl` register in the `sdmmcgrp` group. You can also select which feedback clock (`fb_clk`) to use as the `cclk_in_sample` clock. Set the feedback clock select (`fbclkssel`) bit of the `ctrl` register to control this selection.

 For more information about the SD/MMC controller, refer to the [SD/MMC Controller](#) chapter in volume 3 of the *Cyclone V Device Handbook*.


Watchdog Timer

The system manager controls the watchdog timer behavior when the CPUs are in debug mode. The system manager sends a pause signal to the watchdog timers depending on the setting of the debug mode (`mode[0]` and `mode[1]`) bits of the L4 watchdog debug register (`wddb0g`). Each watchdog timer built into the MPU subsystem is automatically paused when its associated CPU enters debug mode.

 For more information about the watchdog timer, refer to the [Watchdog Timer](#) chapter in volume 3 of the *Cyclone V Device Handbook*.

Boot ROM Code

Registers in the system manager control whether the boot ROM code configures the pin multiplexing for boot pins after a warm reset. Set the warm reset configure pin multiplex for boot pins bit (`warmrstcfpinmux`) of the `ctrl` register in the boot ROM code register group (`romcodegrp`) to enable or disable this control.

 The boot ROM code always configures the pin multiplexing for boot pins after a cold reset.

Registers in the system manager also control whether the boot ROM code configures the I/O pins used during the boot process after a warm reset. Set the warm reset configure IOs for boot pins bit (`warmrstcfgio`) of the `ctrl` register in the `romcodegrp` group to enable or disable this control. By default, the boot ROM code always configures the I/O pins used by boot after a cold reset.

When CPU1 is released from reset and the boot ROM code is located at the CPU1 reset exception address (for a typical case), the boot ROM reset handler code reads the address stored in the CPU1 start address register (`cpulstartaddr`) and jumps to that address to pass control to software.

The preloader state register (`initswstate`) stores the magic number `0x49535756` written by the preloader to indicate there is a valid preloader software image in the on-chip RAM.

There can be up to four preloader images stored in flash memory. The preloader last image loaded register (`initswlastld`) contains the index of the preloader image loaded in the on-chip RAM.

The boot ROM software state register (`bootromswstate`) is a 32-bit general-purpose register reserved for the boot ROM.

The registers in the warm boot from on-chip RAM group (`warmramgrp`) in the `romcodegrp` group are used by the boot ROM code to support booting from the on-chip RAM on a warm reset. Table 14-2 lists the registers and their purposes.

Table 14-2. The `warmramgrp` Registers

Register	Name	Purpose
<code>enable</code>	Enable	Controls whether the boot ROM attempts to boot from the contents of the on-chip RAM on a warm reset.
<code>datastart</code>	Data start	Contains the byte offset of the warm boot CRC validation region in the on-chip RAM. The offset must be word-aligned to an integer multiple of four.
<code>length</code>	Length	Contains the length in bytes of the region in the on-chip RAM available for warm boot CRC validation.
<code>execution</code>	Execution offset	Contains the byte offset into the on-chip RAM that the boot code jumps to if the CRC validation succeeds.
<code>crc</code>	Expected CRC	Contains the expected CRC of the region in the on-chip RAM.

All the registers in Table 14-2 must be written by software prior to the warm reset occurring.

The number of wait states applied to the boot ROM's read operation is determined by the wait state bit (`waitstate`) of the `ctrl` register in the `romhwgrp` group. After the boot process, software might require reading the code in the boot ROM. If software has changed the clock frequency of the `l3_main_clk` after reset, an additional wait state is necessary to access the boot ROM. Set the `waitstate` bit of the `ctrl` register in the `romhwgrp` group to add an additional wait state to the read access of the boot ROM. The enable safe mode warm reset update bit (`ensfmdwru`) of the `ctrl` register controls whether the `waitstate` bit is updated during a warm reset.

Freeze Controller

The freeze controller provides freeze signals to the HPS configurable I/O elements. These freeze signals ensure that the I/O pins are in a safe state upon FPGA power on and until they are configured.

The freeze controller divides the HPS configurable I/O pins into four groups. Each group has an independent set of freeze signals, referred to as a freeze channel, which is driven by the freeze controller. Separate freeze channels allow each group of I/O pins to be independently frozen, configured, and thawed.

The HPS I/O pins are divided into six banks. Each I/O bank is either a vertical (VIO) or horizontal (HIO) I/O, based on its location on the die. [Table 14-3](#) lists the I/O banks and bank types that each freeze channel controls.

Table 14-3. Freeze Channels and HPS I/O Banks

Freeze Channel	Bank Type	HPS I/O Bank
0	VIO	I/O bank 7D and bank 7E
1	VIO	I/O bank 7B and bank 7C
2	VIO	I/O bank 7A
3	HIO	I/O bank 6

When the I/O elements are frozen, the configuration registers in the I/O elements are not placed in a reset state. Instead, the outputs of the configuration registers are gated off by the freeze signals until software running on the HPS thaws the I/O elements. The scan manager must configure the I/O elements in each group before software thaws them.

While frozen, the HPS I/O pins are in the following state:

- I/O buffers are in tri-state mode
- Weak pull-up is enabled
- Outputs of configuration registers are gated
- Internal registers are reset to their initial states
- Bus hold is in tri-state mode
- On-chip termination (OCT) internal timer is reset

Software can generate HPS I/O freeze signals by setting the VIO control (`vioctrl`) and HIO control (`hioctrl`) registers in the freeze control group (`frzctrl`). The system manager allows the following options to be set in the HPS VIO and HIO banks:

- Enable or disable I/O pin configuration
- Allow I/O pin configuration to control the bus hold circuit
- Allow I/O pin configuration to control I/O tri-state
- Allow I/O pin configuration to control weak pull-up resistor
- Allow I/O pin configuration to control the slew-rate
- Reset registers in the delay-locked loop (DLL)
- Reset registers in the OCT

- Reset registers in the I/O elements and data strobe (DQS)
- Disable I/O pin configuration in the OCT calibration block, or start OCT calibration state machine and enable I/O pin configuration in the OCT calibration block

Software controls each freeze channel through a set of memory-mapped control register fields in the system manager. The freeze signals for VIO channel 1 is controlled either by a software state machine, or by a hardware state machine in the freeze controller. Software chooses between the two freeze signal sources by setting the source register (*src*) in the *frzctrl* group.

The system manager initiates a freeze or thaw operation on VIO channel 1 through the hardware state machine. Freeze or thaw is initiated by requesting the hardware state machine to generate a freeze signal sequence. This sequence transitions between frozen and thawed states by setting the VIO channel 1 freeze/thaw request bit (*violreq*) of the hardware control register (*hwctrl*) in the *frzctrl* group.

The system manager allows software to determine the current state of the VIO channel 1 (frozen or thawed) or to determine when a freeze or thaw request is made by reading the VIO channel 1 state bit (*violstate*) of the *hwctrl* register in the *frzctrl* group.

FPGA Interface Enables

The system manager can enable or disable interfaces between the FPGA and HPS. The interfaces must be disabled when not in use to avoid undefined behavior.

The global interface bit (*intf*) of the global disable register (*gbl*) in the FPGA interface group (*fpgaintfgrp*) disables all interfaces between the FPGA and HPS.



Ensure that all interfaces between the FPGA and HPS are inactive before disabling them.

You can set the individual disable register (*indiv*) in the *fpgaintfgrp* group to disable the following interfaces between the FPGA and HPS:

- Reset request interface
- JTAG enable interface
- I/O configuration interface
- Boundary scan interface
- Trace interface
- System Trace Macrocell (STM) interface
- Cross-trigger interface (CTI)

ECC and Parity Control

The system manager can enable or disable ECC for each of the following HPS modules with ECC-protected RAM:

- MPU L2 cache data RAM
- On-chip RAM

- USB 2.0 OTG controller (USB0 and USB1) RAM
- EMAC (EMAC0 and EMAC1) RAM
- DMA controller RAM
- CAN controller RAM
- NAND flash controller RAM
- Quad SPI flash controller RAM
- SD/MMC controller RAM

With the exception of L2 cache data RAM, each of the ECC memories generates a single- and double-bit interrupt to the global interrupt controller (GIC) through the system manager. Set the registers in the ECC management register group (`eccgrp`) to enable or disable the ECC. The L2 cache generates the L2 cache data RAM interrupt directly.

The system manager can inject single-bit or double-bit errors into each of the ECC memories for testing purposes. Set the bits in the appropriate memory enable register to inject errors. For example, to inject a single bit EEC error into the USB0 module, set the `injs` bit of the USB0 RAM ECC enable register (`usb0`) in the ECC management register group (`eccgrp`).

The system manager can also inject parity failures into the parity-protected RAM in the MPU to test the parity failure interrupt handler. Set the bits of the parity fail injection register (`parityinj`) to inject parity failures.

Pin Multiplexing Control

In the HPS, many of the pins are available for use by as many as four peripherals. The system manager allows software to control pin multiplexing selections to select which peripheral in the HPS has access to each shared pin. Some pins also provide boot source and clock source information, which are sampled upon deassertion of a cold reset event. Set the registers in the pin multiplexing control group (`pinmuxgrp`) to control this selection.




Do not modify the pin multiplexing selection registers after I/O configuration.

Preloader Handoff Information

The system manager provides eight 32-bit registers to store handoff information between the preloader and the operating system. The preloader can store any information in these registers. These register contents have no impact on the state of the HPS hardware. When the operating system kernel boots, it retrieves the information by reading the preloader to OS handoff information register (`handoff`) array in the preloader register group (`iswgrp`). These registers are reset only by a cold reset.

Clocks

The system manager is driven by the `osc1_clk` clock generated by the clock manager.

 For more information about the clock manager, refer to the *Clock Manager* chapter in volume 3 of the *Cyclone V Device Handbook*.


Resets

The system manager receives two reset signals from the reset manager. The `sys_manager_rst_n` signal is driven on a cold or warm reset and the `sys_manager_cold_rst_n` signal is driven only on a cold reset. This functionality allows the system manager to reset some CSR fields on either a cold or warm reset and others only on a cold reset.


Table 14-4 lists the registers and groups of registers that are reset by a cold or warm reset.

Table 14-4. Registers and Corresponding Reset Signal

Register or Group	Cold Reset	Warm Reset
fpgaintfgrp	✓	—
scanmgrgrp	✓	—
frzctrl	✓	—
emacgrp	✓	✓
dmagr	✓	✓
sdmmcgrp	✓	✓
nandgrp	✓	✓
usbgrp	✓	✓
eccgrp	✓	—
pinmuxgrp	✓	—
wddbg	✓	—
parityinj	✓	✓
romcodegrp	✓	—
romhwgrp	✓	—

 For more information about the reset manager, refer to the *Reset Manager* chapter in volume 3 of the *Cyclone V Device Handbook*.

System Manager Address Map and Register Definitions

 The address map and register definitions reside in the [hps.html](#) file that accompanies this handbook volume. Click the link to open the file.

To view the module description and base address, scroll to and click the link for the following module instance:

■ sysmgr

To then view the register and field descriptions, scroll to and click the register names. The register addresses are offsets relative to the base address of each module instance.



The base addresses of all modules are also listed in the *Introduction to the Hard Processor System* chapter in volume 3 of the *Cyclone V Device Handbook*.

Document Revision History

Table 14-5 shows the revision history for this document.

Table 14-5. Document Revision History

Date	Version	Changes
November 2012	1.2	Minor updates.
May 2012	1.1	Added functional description, address map and register definitions sections.
January 2012	1.0	Initial release.

The scan manager is used to configure and manage the hard processor system (HPS) I/O pins, and communicate with the FPGA JTAG test access port (TAP) controller. The scan manager drives the HPS I/O scan chains to configure the I/O bank properties before the pins are used by the peripherals in HPS. The scan manager can also optionally communicate with the FPGA JTAG TAP controller to send commands for purposes such as managing cyclic redundancy check (CRC) errors detected by the FPGA control block. When the scan manager communicates with the FPGA JTAG TAP controller, input on the FPGA JTAG pins is ignored.

The scan manager contains an ARM® JTAG Access Port (JTAG-AP). The JTAG-AP implements a multiple scan-chain JTAG master interface. One scan chain connects to the FPGA JTAG and uses the standard JTAG signals. Four other scan chains connect to the HPS I/O banks, using the JTAG clock and data outputs as a parallel-to-serial converter.



For more information about the ARM JTAG-AP, refer to the *ARM Debug Interface v5 Architecture Specification*, which you can download from the ARM website (infocenter.arm.com).

Features of the Scan Manager

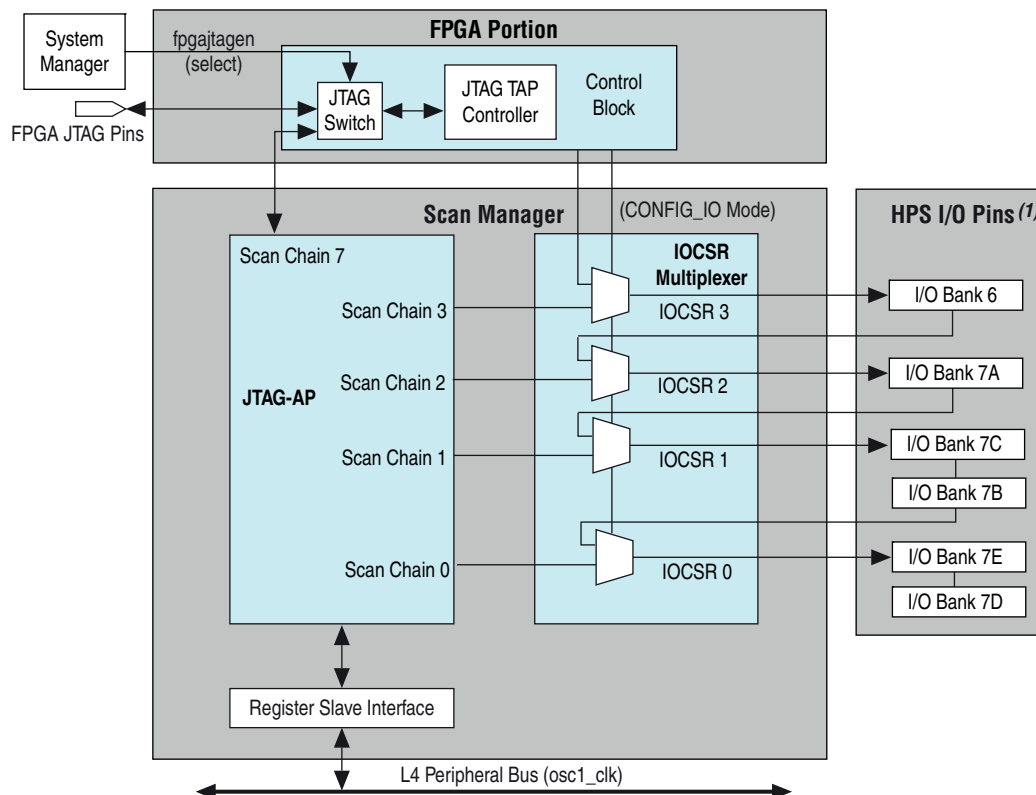
The scan manager has the following features:

- Drives all the I/O scan chains for HPS I/O banks
- Allows the HPS to access the FPGA JTAG TAP controller

Scan Manager Block Diagram and System Integration

Figure 15-1 shows a block diagram of the scan manager, showing how it is integrated in the SoC device.

Figure 15-1. Scan Manager Block Diagram



Note to Figure 15-1:

(1) Not all devices contain all the banks depicted.

The processor accesses the scan manager through the register slave interface connected to the level 4 (L4) peripheral bus.

Table 15-1 describes how the ARM JTAG-AP signals are connected in the scan manager. These signals are internal to the scan manager, are provided here for reference only, and are not shown in Figure 15-1. The signal, register, and field names listed in the table match the names used in the *ARM Debug Interface v5 Architecture Specification*. The remainder of this chapter uses register and field names as listed in the Altera SoC register documentation. Refer to Table 15-3 to cross-reference the two sets of register names.

Table 15-1. ARM JTAG-AP Signal Use in the Scan Manager (Part 1 of 2)

Signal	Direction	Implementation
SRSTCONNECTED[7:0]	Input	Tied to 0. The read-only SRSTCONNECTED field in the CSW register always reads as 0.
PORTCONNECTED[7:0]	Input	Tied to 0x8F, which connects only ports 0-3 and 7. The read-only PORTCONNECTED field in the CSW register reads as 1 when the PORTSEL register is written with a value that enables one of the connected ports, and reads as 0 otherwise.

Table 15–1. ARM JTAG-AP Signal Use in the Scan Manager (Part 2 of 2)

Signal	Direction	Implementation
PORTENABLED[7:0]	Input	Tied to 0x8F, so all connected ports are always considered powered on. The PSTA register does not contain a useful value, so there is no reason for software to access it. Software does not need to monitor the status of ports 0-3 because are always on. For port 7, software can read the mode field of the stat register in the FPGA manager to determine the FPGA power status.
nSRSTOUT[7:0]	Output	Not connected. Writing to the SRST_OUT field of the CSW register has no effect.
nTRST*[7:0]	Output	nTRST*[7] is connected to the FPGA JTAG TAP controller and nTRST*[6:0] are not connected. Writing to the TRST_OUT field of the CSW register (the trst bit of the stat register in the scan manager) has an effect only when port 7 is enabled by software. For details, refer to “Communicating with the JTAG TAP Controller” on page 15–5 .

The ARM JTAG-AP supports up to eight scan chains. The scan manager uses only scan chains 0, 1, 2, 3, and 7.

Scan chain 7 of the JTAG-AP connects to FPGA JTAG TAP controller. When the system manager undergoes a cold reset, this connection is disabled and the FPGA JTAG pins are connected to the FPGA JTAG TAP controller. You can configure the system manager to enable the connection, which allows software running on the HPS to communicate with the FPGA JTAG TAP controller. In this case, software can send JTAG commands (such as the SHIFT_EDERROR_REG JTAG instruction) to the FPGA JTAG and get responses to determine details about CRC errors detected by the control block when the FPGA fabric is in user mode. Through the FPGA manager, software can determine that a CRC error was detected. For more information about the TAP controller, refer to [“Communicating with the JTAG TAP Controller” on page 15–5](#).

Scan chains 0 to 3 of the JTAG-AP connect to the configuration information in the HPS I/O scan chain banks through the I/O configuration shift register (IOCSR) multiplexer. For more information, refer to [“Configuring HPS I/O Scan Chains” on page 15–4](#).



The I/O scan chains do not use the JTAG protocol. The scan manager uses the JTAG-AP as a parallel-to-serial converter for the I/O scan chains. The I/O scan chains are connected only to the serial output data (TDI JTAG signal) and serial clock (TCK JTAG signal).

The HPS I/O pins are divided into six banks. Each I/O bank is either a vertical (VIO) or horizontal (HIO) I/O, based on its location on the die. [Table 15–2](#) shows the mapping of the IOCSR scan chains to the I/O banks.

Table 15–2. Bank Usage of IOCSR Scan Chains

IOCSR Scan Chain	Bank Type	HPS I/O Bank	Usage
0	VIO	I/O bank 7D and I/O bank 7E	EMAC
1	VIO	I/O bank 7B and I/O bank 7C	SD/MMC, NAND, and quad SPI
2	VIO	I/O bank 7A	Trace, SPI, UART, I ² C, and CAN
3	HIO	I/O bank 6	SDRAM DDR

When the FPGA JTAG TAP controller is in `CONFIG_IO` mode, the controller can override the scan manager JTAG-AP and configure the HPS I/O pins. For more information, refer to “Configuring HPS I/O Scan Chains” on page 15-4.



`CONFIG_IO` mode is commonly used to configure the I/O pin properties prior to performing boundary scan testing.

Functional Description of the Scan Manager

This section describes the functional operation of the scan manager. The scan manager serves the following two purposes:

- Configuring HPS I/O Scan Chains
- Communicating with the JTAG TAP Controller

Configuring HPS I/O Scan Chains

The HPS I/O pins are configured through a series of scan chains.



The HPS I/O pins need to be frozen before configuring them. For more information, refer to the *System Manager* chapter in volume 3 of the *Cyclone V Device Handbook*.

I/O pin configuration involves such steps as setting the I/O standard and drive strength for each I/O bank. After a cold reset, all the I/O scan chains in the HPS must be configured prior to being used to communicate with external devices.

Software uses the scan manager to write configuration data to the scan chains. Separate I/O configuration data files for FPGA and HPS are generated by the Quartus® II software when the configuration image for the FPGA portion of the system-on-a-chip (SoC) device is assembled. The HPS configuration data is written to the scan manager by software.

Before configuring a specific IO bank, the corresponding scan chain must be enabled by writing to the bits in `en` register. The scan manager must not be active during this process. Software reads the active bit of `stat` register to determine the scan manager state.

Alternatively, when the FPGA JTAG TAP controller receives the `CONFIG_IO` JTAG instruction, the control block enters `CONFIG_IO` mode. When the control block is in `CONFIG_IO` mode, the controller can override the scan manager JTAG-AP and configure the HPS I/O pins. The `CONFIG_IO` instruction configures all configurable I/O pins in the SoC device including the FPGA I/O pins and the HPS I/O pins. The FPGA and HPS portions of the device must be both powered on to execute the `CONFIG_IO` instruction. External logic connected to the FPGA JTAG pins sends the `CONFIG_IO` instruction, which provides I/O configuration data for all FPGA and HPS I/O pins. While `CONFIG_IO` mode is active, the HPS is held in cold reset to prevent software from potentially interfering with the I/O configuration.

Communicating with the JTAG TAP Controller

After the system manager undergoes a cold reset, access to the JTAG TAP controller in the FPGA control block is through the dedicated FPGA JTAG I/O pins. If necessary, you can configure your system to use the scan manager to provide the HPS processor access to the JTAG TAP controller instead. This feature allows the processor to send JTAG instructions to the FPGA portion of the device.

To connect scan chain 7 between the scan manager and the FPGA JTAG TAP controller, the following features must be enabled:

- The scan chain for the FPGA JTAG TAP controller—To enable scan chain 7, set the `fpga_jtag` field of the `en` register in the scan manager. For more information, refer to [“Scan Manager Address Map and Register Definitions”](#) on page 15-6.
- The FPGA JTAG logic source select—This source select determines whether the scan manager or the dedicated FPGA JTAG pins are connected to the FPGA JTAG TAP controller in the FPGA portion of the device. On system manager cold reset, the dedicated FPGA JTAG pins are selected. The source select is configured through the `fpga_jtagen` bit of the `ctrl` register in the `scanmgrgrp` group of the system manager. The FPGA JTAG pins and scan manager connection to the TAP controller must both be inactive when switching between them. The mechanism to ensure both are inactive is user-defined.



For more information, refer to the [System Manager](#) chapter in volume 3 of the *Cyclone V Device Handbook*.



Before connecting or disconnecting the scan chain between the scan manager and the FPGA JTAG TAP controller, ensure that both the FPGA JTAG TCK and scan manager TCK signals are de-asserted. Altera recommends resetting the FPGA JTAG TAP controller using the scan manager's `nTRST` signal after the scan manager is connected to the controller.

JTAG-AP FIFO Buffer Access and Byte Command Protocol

The JTAG-AP contains FIFO buffers for byte commands and responses. The buffers are accessed through the `fifosinglebyte`, `fifodoublebyte`, `fifotriplebyte`, and `fifoquadbyte` registers. The JTAG-AP stalls processor access to the registers when the buffer does not contain enough data for read access, or when the buffer does not contain enough free space to accept data for write access.



Software should read the `rfifocnt` and `wfifocnt` fields of the `stat` register to determine the buffer status before performing the access to avoid being stalled by the JTAG-AP.

JTAG-AP scan chains 0, 1, 2 and 3 are write-only ports connected to the HPS IOCSRs and JTAG-AP scan chain 7 is a read-write port connected to the FPGA JTAG TAP controller. The processor can send data to scan chains 0-3, and send and receive data from scan chain 7 by accessing the command and response FIFO buffers in the JTAG-AP.



Attempting to access data at invalid or non-aligned offsets can produce unpredictable results that require a reset to recover.

The JTAG commands and TDI data must be sent to the JTAG-AP using an encoded byte protocol. Similarly, the TDO data received from JTAG-AP is encoded. All commands are 8 bits wide in the byte command protocol.



For details about the byte command protocol, refer to the JTAG-AP chapter in the *ARM Debug Interface v5 Architecture Specification*, which you can download from the ARM website (infocenter.arm.com).

Clocks

The scan manager is connected to the `spl_m_clk` clock generated by the clock manager.



For more information, including minimum and maximum clock frequencies, refer to the *Clock Manager* chapter in volume 3 of the *Cyclone V Device Handbook*.

The scan manager generates two clocks. One clock routes to the control block of the FPGA portion of the SoC device with a frequency of `spl_m_clk` / 6 and runs at a maximum of 33 MHz. The other clock routes to the HPS I/O scan chains with a frequency of `spl_m_clk` / 2 and runs at a maximum frequency of 100 MHz.



The `spl_m_clk` can potentially run faster than the scan manager supports so that SPI masters can support 60 Mbps rates. When the SPI master is running faster than what is supported by the scan manager, the scan manager cannot be used and must be held in reset.

Resets

The reset manager provides the `scan_manager_rst_n` reset signal to the scan manager for both cold and warm resets.

Because glitches can happen on the output clocks during a warm reset, the scan manager temporarily stops generation of the JTAG-AP and I/O configuration clocks. This action ensures that a warm reset does not cause output clock glitches.

Before asserting warm reset, the reset manager sends a request to the scan manager. The scan manager stops the output clock generation and acknowledges the reset manager. The reset manager then issues the warm reset. To enable this warm reset handshake, configure the `scanmgrhsen` bit of the reset manager `ctrl` register.



For more information about reset handshaking, refer to the *Reset Manager* chapter in volume 3 of the *Cyclone V Device Handbook*.

Scan Manager Address Map and Register Definitions



The address map and register definitions reside in the [hps.html](#) file that accompanies this handbook volume. Click the link to open the file.

To view the module description and base address, scroll to and click the link for the following module instance:

■ `scanmgr`

To then view the register and field descriptions, scroll to and click the register names. The register addresses are offsets relative to the base address of each module instance.



The base addresses of all modules are also listed in the *Introduction to the Hard Processor System* chapter in volume 3 of the *Cyclone V Device Handbook*.

To improve clarity regarding how Altera uses the JTAG-AP, the ARM register names are changed in the SoC device. Table 15-3 cross references the ARM and Altera names.

Table 15-3. JTAG-AP Register Names

Altera Name	ARM Name
stat	CSW (control/status word)
en	PSEL
fifosinglebyte	BWFIFO1 for writes, BRFIFO1 for reads
fifodoublebyte	BWFIFO2 for writes, BRFIFO2 for reads
fifotriplebyte	BWFIFO3 for writes, BRFIFO3 for reads
fifoquadbyte	BWFIFO4 for writes, BRFIFO4 for reads



For more information about the ARM JTAG-AP, refer to the *ARM Debug Interface v5 Architecture Specification*, which you can download from the ARM website (infocenter.arm.com).

Document Revision History

Table 15-4 shows the revision history for this document.

Table 15-4. Document Revision History

Date	Version	Changes
November 2012	1.2	Added JTAG-AP descriptions.
May 2012	1.1	Added block diagram and system integration, functional description, and address map and register definitions sections.
January 2012	1.0	Initial release.

This chapter describes the direct memory access controller (DMAC) contained in the hard processor system (HPS). The DMA controller is used to transfer data between memory and peripherals and other memory locations in the system. The DMA controller is an instance of the ARM® CoreLink™ DMA Controller (DMA-330).



For more information about ARM's DMA-330 controller, refer to the *CoreLink DMA Controller DMA-330 Revision: r1p1 Technical Reference Manual*, available from the ARM website (infocenter.arm.com).

Features of the DMA Controller

The HPS provides one DMAC to handle the data transfer between memory-mapped peripherals and memories, off-loading this work from the microprocessor unit (MPU) subsystem. The DMAC supports memory-to-memory, memory-to-peripheral, and peripheral-to-memory transfers. The DMAC supports up to eight logical channels for different levels of service requirements. It provides up to 31 peripheral handshake interfaces for peripheral hardware flow control.

The DMA controller contains an instruction processing block that enables it to process program code that controls a DMA transfer. It also contains an ARM Advanced Microcontroller Bus Architecture (AMBA®) Advanced eXtensible Interface (AXI™) master interface unit to fetch the program code from system memory into its instruction cache. The AXI master interface is used to perform DMA data transfer as well. The DMA instruction execution engine executes the program code from its instruction cache and schedules read or write AXI instructions through the respective instruction queues. It also contains a multi-FIFO (MFIFO) data buffer that it uses to store data that it reads, or writes, during a DMA transfer.

The DMAC provides 11 interrupt outputs to enable efficient communication of events to the MPU subsystem. The peripheral request interfaces support the connection of DMA-capable peripherals to enable memory-to-peripheral and peripheral-to-memory transfers to occur, without intervention from the processor. Since the HPS supports some peripherals that do not comply with ARM DMA peripheral interface protocol, adapters are added to allow these peripherals to work with the DMAC. The following peripheral interface protocols are supported:

- Synopsys protocol
 - Serial peripheral interface (SPI)
 - Universal asynchronous receiver/transmitter (UART)
 - Inter-integrated circuit (I²C)
 - FPGA

- ARM protocol
 - Quad SPI flash controller
 - System trace macrocell (STM™)
- Bosch protocol
 - Controller area network (CAN)

Dual slave interfaces enable the operation of the DMA controller to be partitioned into the Secure state and Non-secure state. The network interconnect must be configured to ensure that only secure transactions can access the secure interface. The slave interfaces can access status registers and also directly execute instructions in the DMA controller.

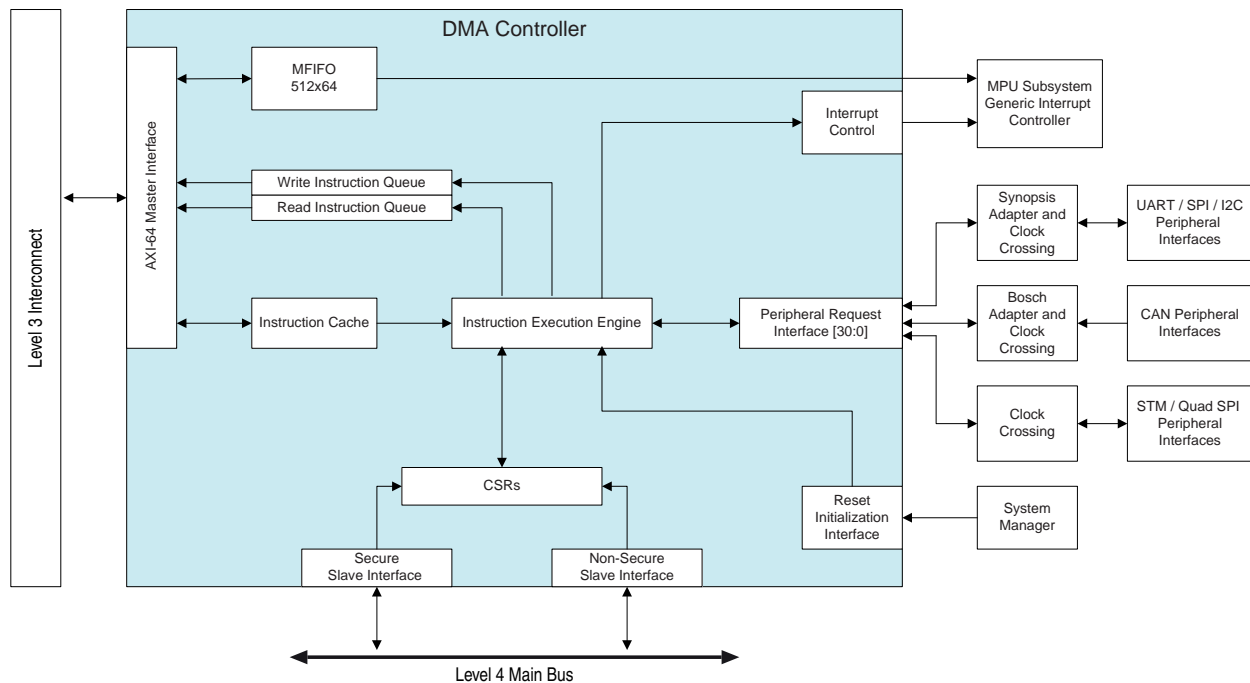
The DMAC has the following features:

- A small instruction set that provides a flexible method of specifying the DMA operations. This architecture provides greater flexibility than the fixed capabilities of a Linked-List Item (LLI) based DMA controller
- Supports multiple transfer types
 - Memory-to-memory
 - Memory-to-peripheral
 - Peripheral-to-memory
 - Scatter-gather
- Supports up to eight DMA channels
- Supports up to eight outstanding AXI read and eight outstanding AXI write transactions.
- Enables software to schedule up to 16 outstanding read and 16 outstanding write instructions
- Supports 11 interrupt lines into the MPU subsystem
 - 1 for DMA thread abort
 - 8 for events
 - 2 for MFIFO buffer ECC
- Supports 31 peripheral request interfaces
 - 4 for FPGA
 - 4 shared for FPGA or CAN
 - 8 for I²C
 - 8 for SPI
 - 2 for quad SPI
 - 1 for System Trace Macrocell
 - 4 for UART

DMA Controller Block Diagram and System Integration

Figure 16-1 shows a block diagram of the DMAC and how it is integrated into the rest of the HPS system.

Figure 16-1. DMA Controller Connectivity



The DMA controller is driven by the `l4_main_clk` clock, which is used for the controller logic as well as all the interfaces. The DMA controller accesses the level 3 (L3) main switch with its 64-bit AXI master interface.

The DMA controller provides the following slave interfaces:

- Non-secure slave interface
- Secure slave interface

You can use these slave interfaces to access the registers that control the functionality of the DMA controller. The DMA controller implements TrustZone® secure technology with one interface operating in the Secure state and the other operating in the Non-secure state.

Functional Description of the DMA Controller

This section describes the major interfaces and components of the DMAC, and how it operates.

Overview

The DMAC contains an instruction processing block that enables it to process program code that controls a DMA transfer. The program code is stored in a region of system memory that the DMAC accesses using its AXI master interface. The DMAC stores instructions temporarily in an internal cache.

The DMAC is configured with eight DMA channels, with each channel capable of supporting a single concurrent thread of DMA operation. In addition, a single DMA manager thread exists, and you can use it to initialize the DMA channel threads. The DMAC executes up to one instruction per clock cycle. To ensure that it regularly executes each active thread, it alternates by processing the DMA manager thread and then a DMA channel thread. It uses a round-robin process when selecting the next active DMA channel thread to execute.

The DMAC uses variable-length instructions that consist of one to six bytes. It provides a separate program counter (PC) register for each DMA channel. When a thread requests an instruction from an address, the cache performs a lookup. If a cache hit occurs, then the cache immediately provides the instruction. Otherwise, the thread is stalled while the DMAC uses the AXI master interface to perform a cache line fill. If an instruction spans the end of a cache line, the DMAC performs multiple cache accesses to fetch the instruction.



When a cache line fill is in progress, the DMAC enables other threads to access the cache, but if another cache miss occurs, this stalls the pipeline until the first line fill is complete.

When a DMA channel thread executes a load or store instruction, the DMAC adds the instruction to the relevant read or write queue. The DMAC uses these queues as an instruction storage buffer prior to it issuing the instructions on the AXI. The DMAC also contains an MFIFO data buffer that it uses to store data that it reads, or writes, during a DMA transfer.

The DMAC provides multiple interrupt outputs to enable efficient communication of events to external microprocessors. The peripheral request interfaces support the connection of DMA-capable peripherals to enable memory-to-peripheral and peripheral-to-memory DMA transfers to occur, without intervention from a microprocessor.

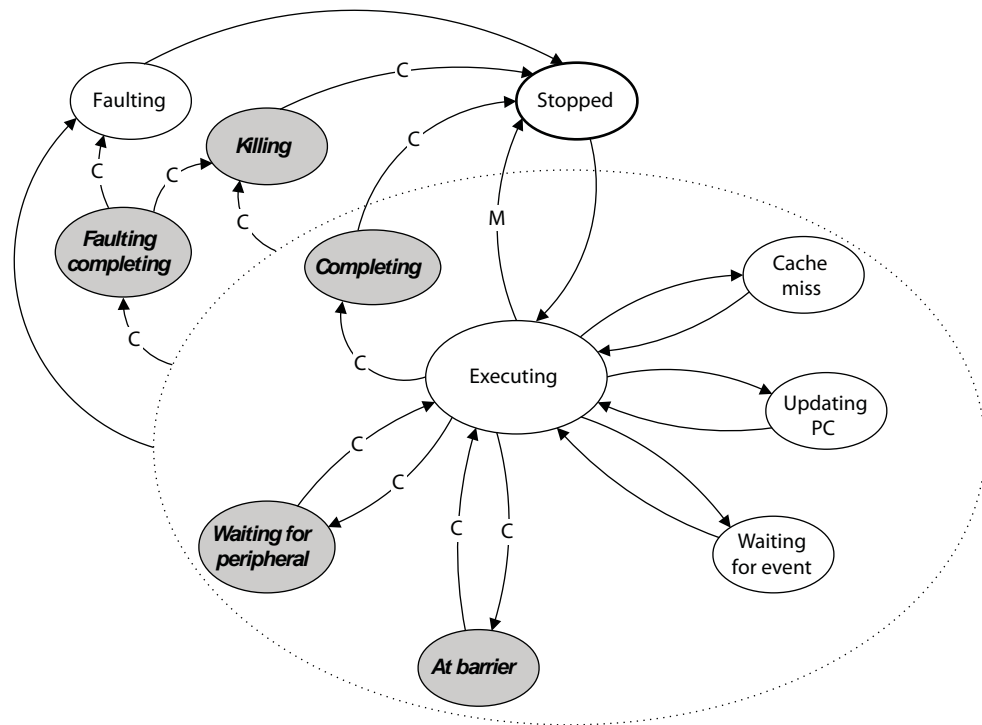
Dual slave interfaces enable the operation of the DMAC to be partitioned into the Secure state and Non-secure states. You can use the slave interfaces to access status registers and also directly execute instructions in the DMAC.


Operating States

Figure 16-2 shows the transitions among operating states for the DMA manager thread and DMA channel threads.

The DMAC provides a separate state machine for each thread.

Figure 16-2. Thread Operating States



 In Figure 16-2, the DMAC permits that:

- Only DMA channel threads can use states shown in gray
- Arcs with no letter designator indicate state transitions for the DMA manager and DMA channel threads, otherwise use is restricted as follows:
 - C—DMA channel threads only.
 - M—DMA manager thread only.
- States within the dotted line can transition to the Faulting completing, Faulting, or Killing

After the DMAC exits from reset, it sets all DMA channel threads to the Stopped state, and DMA manager thread moves to the Stopped state.

The following sections describe the states:

- “Stopped” on page 16-6
- “Executing” on page 16-6
- “Cache Miss” on page 16-7
- “Updating PC” on page 16-7
- “Waiting For Event” on page 16-7
- “At Barrier” on page 16-7
- “Waiting For Peripheral” on page 16-7

- “Faulting Completing” on page 16-7
- “Faulting” on page 16-7
- “Killing” on page 16-7
- “Completing” on page 16-7

Stopped

The thread has an invalid PC and it is not fetching instructions. Depending on the thread type, you can cause the thread to move to the Executing state by:

- DMA manager thread—Issuing the DMAGO instruction through the slave interface.
- DMA channel thread—Programming the DMA manager thread to execute DMAGO for a DMA channel thread in the Stopped state.

Executing

The thread has a valid PC and therefore the DMAC includes the thread when it arbitrates. The thread can then change to one of the following states under the following conditions:

- Stopped—When the DMA manager thread executes DMAEND.
- Cache miss—When the instruction cache does not contain the next instruction for either the DMA manager thread or the DMA channel thread.
- Updating PC—When the DMAC calculates the address of the next access in the cache.
- Waiting for event—When a thread executes DMAWFE.
- At barrier—When a DMA channel thread either:
 - Executes DMARMB, DMAWMB, or DMAFLUSHP
 - Updates control registers that affect alignment, refer to “Updating DMA Channel Control Registers During a DMA Cycle” on page 16-25.
- Waiting for peripheral—When a DMA channel thread executes DMAWFP.
- Killing—When a DMA channel thread executes DMAKILL.
- Faulting completing—For a DMA channel thread when either:
 - The thread executes an undefined or invalid instruction
 - An AXI error occurs during an instruction fetch or data transfer.
- Faulting—For the DMA manager thread when either:
 - The thread executes an undefined or invalid instruction
 - An AXI error occurs during an instruction fetch.

For a DMA channel thread when a watchdog timeout abort occurs.
- Completing—When a DMA channel thread executes DMAEND.

Cache Miss

The thread is stalled and the DMAC is performing a cache line fill. After it completes the cache fill, the thread returns to the Executing state.

Updating PC

The DMAC is calculating the address of the next access in the cache. After it calculates the PC, the thread returns to the Executing state.

Waiting For Event

The thread is stalled and is waiting for the DMAC to execute `DMASEV` using the corresponding event number. After the corresponding event occurs, the thread returns to the Executing state.

At Barrier

A DMA channel thread is stalled and the DMAC is waiting for transactions on the AXI to complete. After the AXI transactions complete, the thread returns to the Executing state.

Waiting For Peripheral

A DMA channel thread is stalled and the DMAC is waiting for the peripheral to provide the requested data. After the peripheral provides the data, the thread returns to the Executing state.

Faulting Completing

A DMA channel thread is waiting for the AXI master interface to signal that the outstanding load or store transactions are complete. After the transactions complete, the thread moves to the Faulting state.

Faulting

The thread is stalled indefinitely. The thread moves to the Stopped state when you use the `DBGCMD` register to instruct the DMAC to execute `DMAKILL` for that thread.

Killing

A DMA channel thread is waiting for the AXI master interface to signal that the outstanding load or store transactions are complete. After the transactions complete, the thread moves to the Stopped state.

Completing

A DMA channel thread is waiting for the AXI master interface to signal that the outstanding load or store transactions are complete. After the transactions complete, the thread moves to the Stopped state.

Initializing the DMAC

The DMAC provides several memory-mapped control signals that initialize its operating state when it exits from reset. The DMAC is configured so that it does not automatically begin executing code when it exits from reset. The three memory-mapped control signals are controlled by the system manager.



For further information, refer to the *System Manager* chapter in volume 3 of the *Cyclone® V Device Handbook*.

How to Set the Security State of the DMA Manager

The `boot_manager_ns` signal is the only method to set the security state of the DMA manager.

When the DMAC exits from reset, it reads the status of the `boot_manager_ns` signal and sets the security of the DMA manager.



When set, the security state remains constant until a state transition on the `dma_rst_n` signal resets the DMAC.

Refer to “DMA Manager Thread in Secure State” on page 16–20 and “DMA Manager Thread in Non-Secure State” on page 16–21 for a description of how the security state of the DMA manager affects how the DMAC operates.

How to Set the Security State for the Interrupt Outputs

The DMAC provides the `boot_irq_ns[7:0]` signals to enable you to assign each `irq[x]` signal to a security state.

The `boot_irq_ns[7:0]` signals are connected to the system manager. Before taking the DMA out of reset, you should program `boot_irq_ns[7:0]` through the system manager to control which interrupt bits are secure.



The DMAC samples these bits immediately after it comes out of reset, and then ignores them until the next reset.

When set, the security state of each `irq[x]` remains constant until a state transition on the `dma_rst_n` signal resets the DMAC.

Refer to “Security Usage” on page 16–20 for a description of how the security state of the `irq[x]` signals affects how the DMAC executes the `DMAWFE` and `DMASEV` instructions.

How to Set the Security State for a Peripheral Request Interface

The DMAC provides the `boot_periph_ns[31:0]` signals to enable you to assign each peripheral request interface to a security state.

The `boot_periph_ns[31:0]` signals are connected to the system manager. Before taking the DMA out of reset, you should program the `boot_periph_ns[31:0]` signals through the system manager to control which peripheral interfaces are secure.



The DMAC samples these bits immediately after it comes out of reset, and then ignores them until the next reset. When set, the security state of each peripheral request interface remains constant until a state transition on the `dma_rst_n` signal resets the DMAC.

Refer to “[Security Usage](#)” on page 16–20 for how the security state of the peripheral request interfaces affects how a DMA channel thread executes the `DMAWFP`, `DMALDP`, `DMASTP`, or `DMAFLUSHP` instructions.

Using the Slave Interfaces

The slave interfaces connect the DMAC to the level 4 (L4) main bus and enable a microprocessor to access the registers. Using these registers, a microprocessor can:

- Access the status of the DMA manager thread
- Access the status of the DMA channel threads
- Enable or clear interrupts
- Enable events
- Issue an instruction for the DMAC to execute by programming the following debug registers:
 - `DBGCMD` register
 - `DBGINST0` register
 - `DBGINST1` register

Issuing Instructions to the DMAC using a Slave Interface

When the DMAC is operating, you can only issue the following limited subset of instructions:

- `DMAGO`—Starts a DMA transaction using a DMA channel that you specify.
- `DMASEV`—Signals the occurrence of an event, or interrupt, using an event number that you specify.
- `DMAKILL`—Terminates a thread.

You must ensure that you use the appropriate slave interface, depending on the security state in which the `boot_manager_ns` signal initializes the DMAC to operate. For example, if the DMAC is in the Secure state, you must issue the instruction using the secure slave interface, otherwise the DMAC ignores the instruction. You can use the secure or non-secure slave interface to start or restart a DMA channel when the DMAC is in the Non-secure state.



Before you can issue instructions using the debug instruction registers or the `DBGCMD` register, you must read the `DBGSTATUS` register to ensure that debug is idle, otherwise the DMAC ignores the instructions.

When the DMAC receives an instruction from a slave interface, it can take several clock cycles before it can process the instruction, for example, if the pipeline is busy processing another instruction.



Prior to issuing DMAGO, you must ensure that the system memory contains a suitable program for the DMAC to execute, starting at the address that the DMAGO specifies.

Using DMAGO with the Debug Instruction Registers

This example shows the necessary steps to start a DMA channel thread using the debug instruction registers.

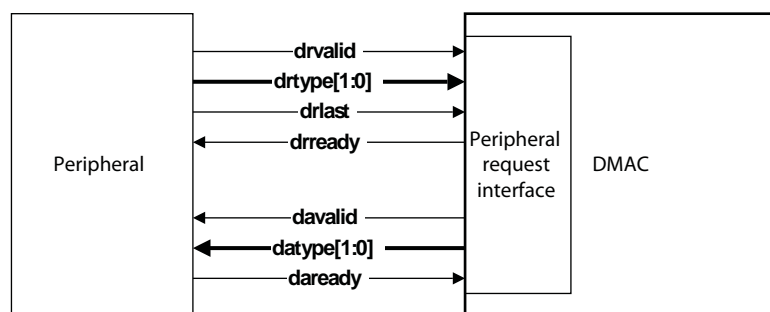
1. Create a program for the DMA channel.
2. Store the program in a region of system memory.
3. Use one of the slave interfaces on the DMAC to program a DMAGO instruction as follows:
 - a. Poll the DBGSTATUS register to ensure that debug is idle, that is, the dbgstatus bit is 0.
 - b. Write to the DBGINST0 register and enter the:
 - Instruction byte 0 encoding for DMAGO.
 - Instruction byte 1 encoding for DMAGO.
 - Debug thread bit to 0. This selects the DMA manager thread.
 - c. Write to the DBGINST1 register with the DMAGO instruction byte [5:2] data. You must set these four bytes to the address of the first instruction in the program, that is written to system memory in step b.
4. Instruct the DMAC to execute the instruction that the debug instruction registers contain by writing zero to the DBGCMD register. The DMAC starts the DMA channel thread and sets the dbgstatus bit to 1. After the DMAC completes execution of the instruction, it clears the dbgstatus bit to 0.

Peripheral Request Interface

Figure 16-3 shows that the peripheral request interface consists of a peripheral request bus and a DMAC acknowledge bus that use the prefixes:

- dr—The peripheral request bus.
- da—The DMAC acknowledge bus.

Figure 16-3. Request and Acknowledge Buses on the Peripheral Request Interface



The peripheral signals the following on the request bus:

- Request a single transfer
- Request a burst transfer
- Acknowledge a flush request.

The peripheral signals the DMAC when it issues the last request of the DMA transfer sequence.

The DMAC can signal the following on the acknowledge bus:

- Signal when it completes the requested single transfer
- Signal when it completes the requested burst transfer
- Issue a flush request.

The DMAC allows you to assign a peripheral request interface to any of the DMA channels. When a DMA channel thread executes `DMAWFP`, the value programmed in the peripheral [4:0] field specifies the peripheral associated with that DMA channel. For more information, refer to “[DMAWFP](#)” on page 16-43.

The DMAC supports 31 peripheral request handshakes. Each request handshake can receive up to four outstanding requests, and is assigned a specific peripheral device ID. [Table 16-1](#) lists the peripheral device ID assignments.

Table 16-1. Peripheral Request Interface Mapping

Peripheral	Request Interface ID	Protocol	Peripheral	Request Interface ID	Protocol
FPGA 0	0	Synopsys	SPI Master 0 TX	16	Synopsys
FPGA 1	1	Synopsys	SPI Master 0 RX	17	Synopsys
FPGA 2	2	Synopsys	SPI Slave 0 TX	18	Synopsys
FPGA 3	3	Synopsys	SPI Slave 0 RX	19	Synopsys
FPGA 4 / CAN 0 interface 1	4	Synopsys / Bosch	SPI Master 1 TX	20	Synopsys
FPGA 5 / CAN 0 interface 2	5	Synopsys / Bosch	SPI Master 1 RX	21	Synopsys
FPGA 6 / CAN 1 interface 1	6	Synopsys / Bosch	SPI Slave 1 TX	22	Synopsys
FPGA 7 / CAN 1 interface 2	7	Synopsys / Bosch	SPI Slave 1 RX	23	Synopsys
I ² C 0 TX	8	Synopsys	Quad SPI Flash TX	24	ARM
I ² C 0 RX	9	Synopsys	Quad SPI Flash RX	25	ARM
I ² C 1 TX	10	Synopsys	STM	26	ARM
I ² C 1 RX	11	Synopsys	Reserved	27	—
I ² C 2 TX (EMAC)	12	Synopsys	UART 0 TX	28	Synopsys
I ² C 2 RX (EMAC)	13	Synopsys	UART 0 RX	29	Synopsys
I ² C 3 TX (EMAC)	14	Synopsys	UART 1 TX	30	Synopsys
I ² C 3 RX (EMAC)	15	Synopsys	UART 1 RX	31	Synopsys

Request interface numbers 4 through 7 are multiplexed between the CAN controllers and soft logic implemented in the FPGA fabric. The switching between the CAN controller and FPGA interfaces is controlled by the system manager.



For more information about controlling request interface numbers 4 through 7 refer to the *System Manager* chapter in volume 3 of the *Cyclone V Device Handbook*.

Request Acceptance Capability

The DMAC is able to accept one active request for each peripheral request interface. An active request is where the DMAC has not started the requested AXI data transfers.

Peripheral Length Management

The peripheral request interface enables a peripheral to control the quantity of data that a DMA cycle contains, without the DMAC being aware of how many data transfers it contains. The peripheral controls the DMA cycle in one of the following ways:

- Selects a single transfer
- Selects a burst transfer
- Notifies the DMAC when it commences the final request in the current series

When the DMAC executes a `DMAWFP` `periph` instruction, it halts execution of the thread and waits for the peripheral to send a request. When the peripheral sends the request, the DMAC sets the state of the request flags depending on the state of the following signals:

- `drtype_<x>[1:0]`—The DMAC sets the state of the `request_type` flag:
 - `drtype_<x>[1:0]=b00`—`request_type<x> = Single`.
 - `drtype_<x>[1:0]=b01`—`request_type<x> = Burst`.
- `drlast_<x>`—The DMAC sets the state of the `request_last` flag:
 - `drlast_<x>=0`—`request_last<x> = 0`.
 - `drlast_<x>=1`—`request_last<x> = 1`.



If the DMAC executes a `DMAWFP` single or `DMAWFP` burst instruction then the DMAC sets:

- The `request_type<x>` flag to Single or Burst, respectively
- The `request_last<x>` flag to 0.

`DMALPFE` is an assembler directive which forces the associated `DMALPEND` instruction to have its `nf` bit set to 0. This creates a program loop that does not use a loop counter to terminate the loop.

The DMAC exits the loop when the `request_last` flag is set to 1.

The DMAC conditionally executes the following instructions, depending on the state of the `request_type` and `request_last` flags:

- `DMALD`, `DMAST`, `DMALPEND`

When these instructions use the optional `B|S` suffix then the DMAC executes a `DMANOP` if the `request_type` flag does not match.

- `DMALDP<B|S>, DMASTP<B|S>`

The DMAC executes a `DMANOP` if the `request_type<x>` flag does not match the `B|S`

- `DMA LPEND`

When the `nf` bit is 0, the DMAC executes a `DMANOP` if the `request_last` flag is set.

Use the `DMALDB`, `DMALDPB`, `DMASTB` and `DMASTPB` instructions if you require the DMAC to issue a burst transfer when the DMAC receives a burst request. The values in the `CCRn` register control the amount of data that the DMAC transfers.

Use the `DMALDS`, `DMALDPS`, `DMASTS` and `DMASTPS` instructions if you require the DMAC to issue a single transfer when the DMAC receives a single request. The DMAC ignores the value of the `src_burst_len` and `dst_burst_len` fields in the `CCRn` register and sets the `arlen[3:0]` or `awlen[3:0]` buses to 0x0.

DMAC Length Management

DMAC length management is when the DMAC controls the total amount of data to transfer. The peripheral uses the peripheral request interface to notify the DMAC when it requires the DMAC to transfer data to or from the peripheral. The DMA channel thread controls how the DMAC responds to the peripheral requests.

The following constraints apply to DMAC length management:

- The total quantity of data for all the single requests from a peripheral must be less than the quantity of data for a burst request for that peripheral.



The `CCRn` register controls how much data is transferred for a burst request and a single request. Altera recommends that you do not update a `CCRn` register when a transfer is in progress for channel *n*.

- When the peripheral sends a burst request then the peripheral must not send a single request until the DMAC acknowledges that the burst request is complete.

Use the `DMAWFP` single instruction when you require the program thread to halt execution until the peripheral request interface receives any request type. If the head entry in the request FIFO buffer is of request type:

- Single—The DMAC pops the entry from the FIFO buffer and continues program execution.
- Burst—The DMAC leaves the entry in the FIFO buffer and continues program execution.



The burst request entry remains in the request FIFO buffer until the DMAC executes a `DMAWFP` burst instruction or a `DMAFLUSHP` instruction.

Use the `DMAWFP` burst instruction when you require the program thread to halt execution until the peripheral request interface receives a burst request. If the head entry in the request FIFO buffer is of request type:

- Single—The DMAC removes the entry from the FIFO buffer and program execution remains
- Burst—The DMAC pops the entry from the FIFO buffer and continues program execution.

Use the `DMALDP` instruction when you require the DMAC to send an acknowledgement to the peripheral when it completes the AXI read transfers. Similarly, use the `DMASTP` instruction when you require the DMAC to send an acknowledgement to the peripheral when it completes the AXI write transfers. The DMAC uses the acknowledge bus to signal a transfer acknowledgement to peripheral <x>.



The DMAC sends an acknowledgement for a read transaction when the `rvalid` and `rlast` signals are high and for a write transaction when `bvalid` signal is high. The DMAC might send an acknowledgement to the peripheral while the transfer of write data to the end destination is still in progress.

Use the `DMAFLUSHP` instruction to reset the request FIFO buffer for the peripheral request interface. After the DMAC executes `DMAFLUSHP`, it ignores peripheral requests until the peripheral acknowledges the flush request. This enables the DMAC and peripheral to synchronize with each other.

Limitations

The peripherals connected to the DMA peripheral request interface use one of the following protocols:

- ARM
- Synopsys
- Bosch

For a peripheral using the ARM protocol, the only logic between the DMA and the peripheral is clock crossing logic. For other protocols, clock crossing and protocol adaptation logic is located between the DMA and peripheral. The following sections discuss the limitations of the peripheral handshake interface for peripherals using the Synopsys or Bosch protocols.

Burst Only Request

The Bosch protocol used by the CAN controllers only supports burst requests. As a result any time either CAN controller issues the peripheral burst request the DMA controller receives a burst and single request.

No Flush Support

For peripherals that use the Bosch or Synopsys peripheral request protocols the flush command is not supported. Issuing a flush to any peripheral interface supporting the Bosch or Synopsys protocols is dropped before reaching the peripheral.

No Acknowledge Type

For the Bosch peripheral request interface protocol, there is no acknowledge available. Issuing an acknowledge to either CAN controller as a result is dropped before reaching the peripheral.

For the Synopsys peripheral request interface protocol, there is no acknowledge type available. As a result peripherals using the Synopsys protocol cannot distinguish between acknowledges to burst and single transfers.

Using Events and Interrupts

The DMAC can support eight events and interrupts. The `INTEN` register is used to control if each event-interrupt resource is either an event or an interrupt.

When the DMAC executes a `DMASEV` instruction it modifies the event-interrupt resource that you specify. The `INTEN` register sets the event-interrupt resource to function as an:

- **Event**—The DMAC generates an event for the specified event-interrupt resource. When the DMAC executes a `DMAWFE` instruction for the same event-interrupt resource then it clears the event.
- **Interrupt**—The DMAC sets the `irq<event_num>` signal high, where `<event_num>` is the number of the specified event resource. To clear the interrupt you must write to the `INTCLR` register.

Using an Event to Restart DMA Channels

When you program the `INTEN` register to generate an event, you can use the `DMASEV` and `DMAWFE` instructions to restart one or more DMA channels.

DMAC executes DMAWFE before DMASEV

To restart a single DMA channel:

1. The first DMA channel executes `DMAWFE` and then stalls while it waits for the event to occur.
2. The other DMA channel executes `DMASEV` using the same event number. This generates an event, and the first DMA channel restarts. The DMAC clears the event, one clock cycle after it executes `DMASEV`.

You can program multiple channels to wait for the same event. For example, if four DMA channels have all executed `DMAWFE` for event 2, then when another DMA channel executes `DMASEV` for event 2, the four DMA channels all restart at the same time. The DMAC clears the event, one clock cycle after it executes `DMASEV`.

DMAC executes DMASEV before DMAWFE

If the DMAC executes `DMASEV` before another channel executes `DMAWFE` then the event remains pending until the DMAC executes `DMAWFE`. When the DMAC executes `DMAWFE` it halts execution for one `ac1k` clock cycle, clears the event and then continues execution of the channel thread.

For example, if the DMAC executes `DMASEV 6` and none of the other threads have executed `DMAWFE 6` then the event remains pending. If the DMAC executes `DMAWFE 6` instruction for channel 4 and then executes `DMAWFE 6` instruction for channel 3, then:

1. The DMAC halts execution of the channel 4 thread for one `ac1k` clock.
2. The DMAC clears event 6.
3. The DMAC resumes execution of the channel 4 thread.
4. The DMAC halts execution of the channel 3 thread and the thread stalls while it waits for the next occurrence of event 6.

Interrupting the MPU Subsystem

The DMAC provides the `irq[x]` signals for use as active-high level-sensitive interrupts to the MPU subsystem. When you program the `INTEN` register to generate an interrupt, after the DMAC executes `DMASEV`, it sets the corresponding `irq[x]` signal high.

The MPU subsystem can clear the interrupt by writing to the `INTCLR` register.



Executing `DMAWFE` does not clear an interrupt.

If you use the `DMASEV` instruction to notify a microprocessor when the DMAC completes a `DMALD` or `DMAST` instruction then Altera recommends that you insert a memory barrier instruction before the `DMASEV`. Otherwise the DMAC might signal an interrupt before the AXI transfers complete. Refer to [Example 16-1](#).

Example 16-1. Memory Barrier Instruction

```
DMALD
DMAST
# Issue a write memory barrier
# Wait for the AXI write transfer to complete before the DMAC
# can send an interrupt
DMAWMB
# The DMAC sends the interrupt
DMASEV
```

Aborts

This section describes:

- [Abort Types](#)
- [Abort Sources](#)
- [Watchdog Abort](#)
- [Abort Handling](#)

Abort Types

An abort can be classified as either precise or imprecise, depending on whether the DMAC provides an abort handler with the precise state of the DMAC when the abort occurs. If an abort is:

- **Precise** The DMAC updates the `PC` register with the address of the instruction that created the abort.
- **Imprecise** The `PC` register might contain the address of an instruction which did not cause the abort to occur.

Abort Sources

The DMAC signals a precise abort under the following conditions:

- A DMA channel thread in the Non-secure state attempts to program its `CCRn` register and generate a secure AXI transaction.

- A DMA channel thread in the Non-secure state executes `DMAWFE` or `DMASEV` for an event that is set as secure. The `boot_irq_ns` memory-mapped control signals initialize the security state for an event.



For each event, the `INTEN` register controls if the DMAC generates an event or signals an interrupt.

- A DMA channel thread attempts to execute `DMAST` but the DMAC calculates that when it eventually performs the store, the MFIFO buffer contains insufficient data to enable it to complete the store.
- A DMA channel thread in the Non-secure state executes `DMAWFP`, `DMALDE`, `DMASTP`, or `DMAFLUSHP` for a peripheral request interface that is set as secure. The `boot_periph_ns` memory-mapped control signals initialize the security state for a peripheral request interface.
- A DMA manager thread in the Non-secure state executes `DMAGO` to attempt to start a secure DMA channel thread.
- The DMAC receives an `ERROR` response on the AXI master interface when it performs an instruction fetch.
- A thread executes an undefined instruction.
- A thread executes an instruction with an operand that is invalid for the configuration of the DMAC.



When the DMAC signals a precise abort, the instruction that triggers the abort is not executed. Instead, the DMAC executes a `DMANOP`.

The DMAC signals an imprecise abort under the following conditions:

- The DMAC receives an `ERROR` response on the AXI master interface when it performs a data load
- The DMAC receives an `ERROR` response on the AXI master interface when it performs a data store
- A DMA channel thread executes `DMALD` or `DMAST`, and the MFIFO buffer is too small to hold the required amount of data
- A DMA channel thread executes `DMAST` but the thread has not executed sufficient `DMALD` instructions
- A DMA channel thread locks up because of resource starvation, and this causes the internal watchdog timer to time out.

Watchdog Abort

The DMAC can lock up if one or more DMA channel programs are running and the MFIFO buffer is too small to satisfy the storage requirements of the DMA programs.

The DMAC contains logic to prevent it from remaining in a state where it is unable to complete a DMA transfer.

The DMAC detects a lock up when all of the following conditions occur:

- Load queue is empty

- Store queue is empty
- All of the running channels are prevented from executing a DMALD instruction either because the MFIFO buffer does not have sufficient free space or another channel owns the load-lock.

When the DMAC detects a lockup it signals an interrupt and can also abort the contributing channels. The DMAC behavior depends on the state of the `wd_irq_only` bit in the WD register.

If:

- `wd_irq_only=0`—The DMAC aborts all of the contributing DMA channels and sets the `irq_abort` signal high.
- `wd_irq_only=1`—The DMAC sets the `irq_abort` signal high.

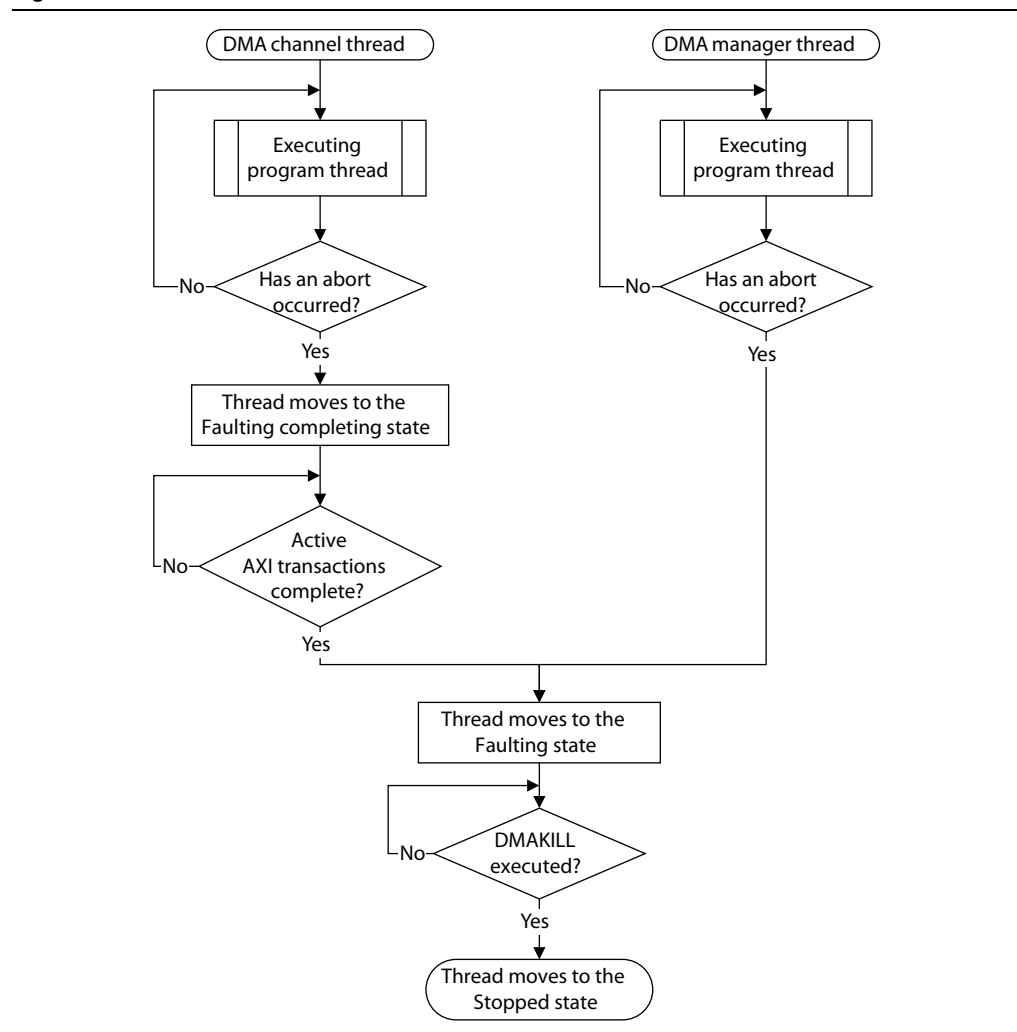
For more information, refer to [“Resource Sharing Between DMA Channels” on page 16-26](#).

Abort Handling

The architecture of the DMAC is not designed to recover from an abort and you must therefore use an external agent, such as a microprocessor, to terminate a thread when an abort occurs.

Figure 16-4 shows the operating states for the DMA channel and DMA manager threads after an abort occurs.

Figure 16-4. Abort Process



After an abort occurs, the action the DMAC takes depends on the thread type:

- **DMA channel thread**—The thread immediately moves to the Faulting completing state. In this state, the DMAC:
 - Sets the `irq_abort` signal high
 - Stops executing instructions for the DMA channel
 - Invalidates all cache entries for the DMA channel updates the `CPCn` register to contain the address of the aborted instruction provided that the abort is precise
 - Does not generate AXI accesses for any instructions remaining in the read queue and write queue
 - Permits currently active AXI transactions to complete.



After the transactions for the DMA channel complete, the thread moves to the Faulting state.


- DMA manager thread—The thread immediately moves to the Faulting state and the DMAC sets the `irq_abort` signal high.

The external agent can respond to the assertion of the `irq_abort` signal by:

- Reading the status of the `FSRD` register to determine if the DMA manager is Faulting. In the Faulting state, the `FSRD` register provides the cause of the abort.
- Reading the status of the `FSRC` register to determine if a DMA channel is Faulting. In the Faulting state, the `FSRC` register provides the cause of the abort.

To enable a thread in the Faulting state to move to the Stopped state, the external agent must:

- Program the `DBGINST0` register with the encoding for the `DMAKILL` instruction.
- Write to the `DBGCMD` register.

 If the aborted thread is secure, you must use the secure slave interface to update these

After a thread in the Faulting state executes `DMAKILL`, it moves to the Stopped state.

Security Usage

When the DMAC exits from reset, the status of the configuration signals configures the security for:

- DMA manager thread—The `DNS` bit in the `DSR` register returns the security state of the DMA manager thread.
- Events and interrupts—The `INS` bit in the `CR3` register returns the security state of the event-interrupt resources.
- Peripheral request interfaces—The `PNS` bit in the `CR4` register returns the security state of these interfaces.

Additionally, each DMA channel thread contains a dynamic non-secure bit, `CNS`, that is valid when the channel is not in the Stopped state.

DMA Manager Thread in Secure State

If the `DNS` bit is 0, the DMA manager thread operates in the Secure state and it only performs secure instruction fetches. When a DMA manager thread in the Secure state processes:

- `DMAGO`—The DMAC uses the status of the `ns` bit, to set the security state of the DMA channel thread by writing to the `CNS` bit for that channel.
- `DMAWFE`—The DMAC halts execution of the thread until the event occurs. When the event occurs, the DMAC continues execution of the thread, irrespective of the security state of the corresponding `INS` bit.
- `DMASEV`—The DMAC sets the corresponding bit in the `INT_EVENT_RIS` register, irrespective of the security state of the corresponding `INS` bit.

DMA Manager Thread in Non-Secure State

If the `DNS` bit is 1, the DMA manager thread operates in the Non-secure state, and it only performs non-secure instruction fetches. When a DMA manager thread in the Non-secure state processes:

- **DMAGO**—The DMAC uses the status of the `ns` bit, to control if it starts a DMA channel thread. If:
 - `ns = 0`—The DMAC does not start a DMA channel thread and instead it:
 - Executes a NOP.
 - Sets the `FSRD` register.
 - Sets the `dmago_err` bit in the `FTRD` register.
 - Moves the DMA manager to the Faulting state.
 - `ns = 1`—The DMAC starts a DMA channel thread in the Non-secure state and programs the `CNS` bit to be non-secure.
- **DMAWFE**—The DMAC uses the status of the corresponding `INS` bit, in the `CR3` register, to control if it waits for the event. If:
 - `INS = 0`—The event is in the Secure state. The DMAC:
 - Executes a NOP.
 - Sets the `FSRD` register.
 - Sets the `mgr_evnt_err` bit in the `FTRD` register.
 - Moves the DMA manager to the Faulting state.
 - `INS = 1`—The event is in the Non-secure state. The DMAC halts execution of the thread and waits for the event to occur.
- **DMASEV**—The DMAC uses the status of the corresponding `INS` bit, in the `CR3` register, to control if it creates the event interrupt. If:
 - `INS = 0`—The event-interrupt resource is in the Secure state. The DMAC:
 - Executes a NOP.
 - Sets the `FSRD` register.
 - Sets the `mgr_evnt_err` bit in the `FTRD` register.
 - Moves the DMA manager to the Faulting state.
 - `INS = 1`—The event-interrupt resource is in the Non-secure state. The DMAC creates the event interrupt.

DMA Channel Thread in Secure State

When the `CNS` bit is 0, the DMA channel thread is programmed to operate in the Secure state and it only performs secure instruction fetches.

When a DMA channel thread in the Secure state processes the following instructions:

- **DMAWFE**—The DMAC halts execution of the thread until the event occurs. When the event occurs, the DMAC continues execution of the thread, irrespective of the security state of the corresponding `INS` bit, in the `CR3` register.

- **DMASEV**—The DMAC creates the event interrupt, irrespective of the security state of the corresponding **INS** bit, in the **CR3** register.
- **DMAWFP**—The DMAC halts execution of the thread until the peripheral signals a DMA request. When this occurs, the DMAC continues execution of the thread, irrespective of the security state of the corresponding **PNS** bit, in the **CR4** register.
- **DMALDP** and **DMASTP**—The DMAC sends a message to the peripheral to communicate that data transfer is complete, irrespective of the security state of the corresponding **PNS** bit, in the **CR4** register.
- **DMAFLUSHP**—The DMAC clears the state of the peripheral and sends a message to the peripheral to resend its level status, irrespective of the security state of the corresponding **PNS** bit, in the **CR4** register.

When a DMA channel thread is in the Secure state, it enables the DMAC to perform secure and non-secure AXI accesses.

DMA Channel Thread in Non-Secure State

When the **CNS** bit is 1, the DMA channel thread is programmed to operate in the Non-secure state and it only performs non-secure instruction fetches.

When a DMA channel thread in the Non-secure state processes the following instructions:

- **DMAWFE**—The DMAC uses the status of the corresponding **INS** bit, in the **CR3** register, to control if it waits for the event. If:
 - **INS** = 0—The event is in the Secure state. The DMAC:
 - Executes a NOP.
 - Sets the appropriate bit in the **FSRC** register that corresponds to the DMA channel number.
 - Sets the **ch_evnt_err** bit in the **FTR_n** register.
 - Moves the DMA channel to the Faulting completing state.
 - **INS** = 1—The event is in the Non-secure state. The DMAC halts execution of the thread and waits for the event to occur.
- **DMASEV**—The DMAC uses the status of the corresponding **INS** bit, in the **CR3** register, to control if it creates the event. If:
 - **INS** = 0—The event-interrupt resource is in the Secure state. The DMAC:
 - Executes a NOP.
 - Sets the appropriate bit in the **FSRC** register that corresponds to the DMA channel number.
 - Sets the **ch_evnt_err** bit in the **FTR_n** register.
 - Moves the DMA channel to the Faulting completing state.
 - **INS** = 1—The event-interrupt resource is in the Non-secure state. The DMAC creates the event interrupt.

- DMAWFP—The DMAC uses the status of the corresponding PNS bit, in the CR4 register, to control if it waits for the peripheral to signal a request. If:
 - PNS = 0—The peripheral is in the Secure state. The DMAC:
 - Executes a NOP.
 - Sets the appropriate bit in the FSRC register that corresponds to the DMA channel number.
 - Sets the ch_periph_err bit in the FTRn register.
 - Moves the DMA channel to the Faulting completing state.
 - PNS = 1—The peripheral is in the Non-secure state. The DMAC halts execution of the thread and waits for the peripheral to signal a request.
- DMALDP and DMASTP—The DMAC uses the status of the corresponding PNS bit, in the CR4 register, to control if it sends an acknowledgement to the peripheral. If:
 - PNS = 0—The peripheral is in the Secure state. The DMAC:
 - Executes a NOP.
 - Sets the appropriate bit in the FSRC register that corresponds to the DMA channel number.
 - Sets the ch_periph_err bit in the FTRn register.
 - Moves the DMA channel to the Faulting completing state.
 - PNS = 1—The peripheral is in the Non-secure state. The DMAC sends a message to the peripheral to communicate when the data transfer is complete.
- DMAFLUSHP—The DMAC uses the status of the corresponding PNS bit, in the CR4 register, to control if it sends a flush request to the peripheral. If:
 - PNS = 0—The peripheral is in the Secure state. The DMAC:
 - Executes a NOP.
 - Sets the appropriate bit in the FSRC register that corresponds to the DMA channel number.
 - Sets the ch_periph_err bit in the FTRn register.
 - Moves the DMA channel to the Faulting completing state.
 - PNS = 1—The peripheral is in the Non-secure state. The DMAC clears the state of the peripheral and sends a message to the peripheral to resend its level status.

When a DMA channel thread is in the Non-secure state, and a DMAMOV CCR instruction attempts to program the channel to perform a secure AXI transaction, the DMAC:

1. Executes a DMANOP.
2. Sets the appropriate bit in the FSRC register that corresponds to the DMA channel number.
3. Sets the ch_rdw_err bit in the FTRn register.
4. Moves the DMA channel thread to the Faulting completing state.

Constraints and Limitations of Use

This section describes constraints and use limitations.

DMA Channel Arbitration

The DMAC uses a round-robin scheme to service the active DMA channels. To ensure that the DMAC continues to service the DMA manager, it always services the DMA manager prior to servicing the next DMA channel.

It is not possible to alter the arbitration process of the DMAC.

DMA Channel Prioritization

The DMAC responds to all active DMA channels with equal priority. It is not possible to increase the priority of a DMA channel over any other DMA channels.

Instruction Cache Latency

When a cache miss occurs, the latency to service the request is mainly dependent on the read latency of the memory containing the DMA code. The latency that the DMAC adds is minimal.

AXI Data Transfer Size

The DMAC can only perform data accesses up to 64 bits in width. If you program the `src_burst_size` or `dst_burst_size` fields to be larger, the DMAC signals a precise abort. Refer to *“Abort Sources” on page 16–16* for more information.

AXI Bursts Crossing 4 KB Boundaries

The AXI specification does not permit AXI bursts to cross 4 KB address boundaries. If you program the DMAC with a combination of burst start address, size, and length that would cause a single burst to cross a 4 KB address boundary, then the DMAC instead generates a pair of bursts with a combined length equal to that specified. This operation is transparent to the DMAC channel thread program so that, for example, the DMAC responds to a single DMALD instruction by generating the appropriate pair of AXI read bursts.

AXI Burst Types

You can program the DMAC to generate only fixed-address or incrementing-address burst types for data accesses. It does not generate wrapping-address bursts for data accesses or for instruction fetches.

AXI Write Addresses

The DMAC can issue up to eight outstanding write addresses. The DMAC does not issue a write address until it has read in all of the data bytes required to fulfill that write transaction.

AXI Write Data Interleaving

The DMAC does not generate interleaved write data. All write data beats for one write transaction are output before any write data beat for the next write transaction.

Programming Restrictions

The following sections describe restrictions that apply when programming the DMAC.

Fixed Unaligned Bursts

The DMAC does not support fixed unaligned bursts. If you program the following conditions, the DMAC treats this as a programming error:

- **Unaligned read**
 - `src_inc` field is 0 in the `CCRn` register.
 - The `SARn` register contains an address that is not aligned to the size of data that the `src_burst_size` field contains.
- **Unaligned write**
 - `dst_inc` field is 0 in the `CCRn` register.
 - The `DARn` register contains an address that is not aligned to the size of data that the `dst_burst_size` field contains.

Endian Swap Size Restrictions

If you program the `endian_swap_size` field in the `CCRn` register, to enable a DMA channel to perform an endian swap, then you must set the corresponding `SARn` register and the corresponding `DARn` register to contain an address that is aligned to the size that the `endian_swap_size` field specifies before executing any `DMALD` or `DMAST` instructions.



If you update any of `endian_swap_size`, `SARn`, or `DARn`, for example, using a `DMAADDH SAR` instruction, then you must ensure that the `SARn` and `DARn` registers contain an address aligned to the size that the `endian_swap_size` field specifies before executing any additional `DMALD` or `DMAST` instructions.

If you program the `src_inc` field in the `CCRn` register to use a fixed address, you must program the `src_burst_size` field to select a burst size that is greater than or equal to the value that the `endian_swap_size` field specifies. Similarly, if you program the `dst_inc` field to select a fixed destination address, you must program the `dst_burst_size` field to select a burst size that is greater than or equal to the value that the `endian_swap_size` field specifies.

If you program the `dst_inc` field in the `CCRn` register to use an incrementing address, you must program the `CCRn` register so that `dst_burst_len` times `dst_burst_size` is a multiple of `endian_swap_size`. For example, if `endian_swap_size` = 2, 32-bit, and `dst_burst_size` = 1, 2 bytes per beat, then you can program `dst_burst_len` = 1, 3, 5, ..., 15, that is 2, 4, 6, ..., 16 transfers.

Updating DMA Channel Control Registers During a DMA Cycle

Prior to the DMAC executing a sequence of `DMALD` and `DMAST` instructions, the values you program in to the `CCRn` register, `SARn` register, and `DARn` register control the data byte lane manipulation that the DMAC performs when it transfers the data from the source address to the destination address.

You can update these registers during a DMA cycle but if you change certain register fields then it can cause the DMAC to discard data. The following sections describe the register fields that might have a detrimental impact on a data transfer.

Updates that affect the destination address

If you use a `DMAMOV` instruction to update the `DARn` register or `CCRn` register part way through a DMA cycle then this might cause a discontinuity in the destination data stream.

A discontinuity occurs if you change any of the following:

- `endian_swap_size` field.
- `dst_inc` bit.
- `dst_burst_size` field when `dst_inc = 0`, that is, fixed-address burst.
- `DARn` register so that it modifies the destination byte lane alignment. Because the bus width is 64 bits, you change bits [2:0] in the `DARn` register.

When a discontinuity in the destination data stream occurs, the DMAC:

1. Halts execution of the DMA channel thread.
2. Completes all outstanding read and write operations for the channel. That is, as if the DMAC were executing `DMARMB` and `DMAWMB`.
3. Discards any residual MFIFO buffer data for the channel.
4. Resumes execution of the DMA channel thread.

Updates that affect the source address

If you use a `DMAMOV` instruction to update the `SARn` register or `CCRn` register part way through a DMA cycle then this might cause a discontinuity in the source data stream.

A discontinuity occurs if you change any of the following:

- `src_inc` bit.
- `src_burst_size` field.
- `SARn` register so that it modifies the source byte lane alignment. Because the bus width is 64 bits, you change bits [2:0] in the `SARn` register.

When a discontinuity in the source data stream occurs, the DMAC:

1. Halts execution of the DMA channel thread.
2. Completes all outstanding read operations for the channel. That is, as if the DMAC were executing `DMARMB`.
3. Resumes execution of the DMA channel thread. No data is discarded from the MFIFO buffer.

Resource Sharing Between DMA Channels

DMA channel programs share the MFIFO buffer data storage resource. You must not start a set of concurrently running DMA channel programs with a resource requirement that exceeds 512, the size of the MFIFO buffer. If you exceed this limit then the DMAC might lock up and generate a Watchdog abort, refer to “[Watchdog Abort](#)” on page 16-17.

The DMAC includes a mechanism called the *load-lock* to ensure that the shared MFIFO buffer resource is used correctly. The load-lock is either owned by one channel, or it is free. The channel that owns the load-lock can execute DMALD instructions successfully. A channel that does not own the load-lock pauses at a DMALD instruction until it takes ownership of the load-lock.

A channel claims ownership of the load lock when:

- It executes a DMALD or DMALDP instruction
- No other channel currently owns the load-lock.

A channel releases ownership of the load-lock when any of the following occur:

- It executes a DMAST, DMASTP, or DMASTZ
- It reaches a barrier, that is, it executes DMARMB or DMAWMB
- It waits, that is, it executes DMAWFP or DMAWFE
- It terminates normally, that is, it executes DMAEND
- It aborts for any reason, including DMAKILL.

The MFIFO buffer resource usage of a DMA channel program is measured in MFIFO buffer entries, and rises and falls as the program proceeds. The MFIFO buffer resource requirement of a DMA channel program is described using a *static requirement* and a *dynamic requirement* which are affected by the load-lock mechanism.

The static requirement is defined to be the maximum number of MFIFO buffer entries that a channel is currently using before that channel does one of the following:

- Executes a WFP or WFE instruction
- Claims ownership of the load-lock.

The dynamic requirement is defined to be the difference between the static requirement and the maximum number of MFIFO buffer entries that a channel program uses at any time during its

To calculate the total MFIFO buffer requirement, add the largest dynamic requirement to the sum of all the static requirements.

To avoid DMAC lockup, the total MFIFO buffer requirement of the set of channel programs must be equal to or less than 512, the MFIFO buffer depth.

For more information, refer to “*MFIFO Buffer Usage Overview*” on page 16–47.

DMA Controller Programming Model

This section describes the instruction set of the DMAC.

Instruction Syntax Conventions

The following conventions are used in assembler syntax prototype lines and their subfields:

- < >

Any item bracketed by < and > is mandatory. A description of the item and of how it is encoded in the instruction is supplied by subsequent text.

■ []

Any item bracketed by [and] is optional. A description of the item and of how its presence or absence is encoded in the instruction is supplied by subsequent

■ Spaces

Single spaces are used for clarity, to separate items. When a space is obligatory in the assembler syntax, two or more consecutive spaces are used.

Instruction Set Summary

The DMAC instructions:

- Use a DMA prefix, to provide a unique name-space
- Have 8-bit opcodes that might use a variable data payload of 0, 8, 16, or 32 bits
- Use suffixes that are consistent.

Table 16–2 shows a summary of the instruction syntax.

Table 16–2. Instruction Syntax Summary

Mnemonic	Instruction	DMA Manager Usage	DMA Channel Usage	Description
DMAADDH	Add Halfword	No	Yes	Refer to “DMAADDH” on page 16–29.
DMAADNH	Add Negative Halfword	No	Yes	Refer to “DMAADNH” on page 16–29.
DMAEND	End	Yes	Yes	Refer to “DMAEND” on page 16–30.
DMAFLUSHP	Flush and Notify Peripheral	No	Yes	Refer to “DMAFLUSHP” on page 16–31.
DMAGO	Go	Yes	No	Refer to “DMAGO” on page 16–31.
DMAKILL	Kill	Yes	Yes	Refer to “DMAKILL” on page 16–32.
DMALD	Load	No	Yes	Refer to “DMALD[S B]” on page 16–33.
DMALDP	Load and Notify Peripheral	No	Yes	Refer to “DMALDP<S B>” on page 16–34.
DMALP	Loop	No	Yes	Refer to “DMALP” on page 16–35.
DMALPEND	Loop End	No	Yes	Refer to “DMALPEND[S B]” on page 16–36.
DMALPFE	Loop Forever	No	Yes	Refer to “DMALPFE” on page 16–38.
DMAMOV	Move	No	Yes	Refer to “DMAMOV” on page 16–38.
DMANOP	No Operation	Yes	Yes	Refer to “DMANOP” on page 16–39.
DMARMB	Read Memory Barrier	No	Yes	Refer to “DMARMB” on page 16–39.
DMASEV	Send Event	Yes	Yes	Refer to “DMASEV” on page 16–40.
DMAST	Store	No	Yes	Refer to “DMAST[S B]” on page 16–40.
DMASTP	Store and Notify Peripheral	No	Yes	Refer to “DMASTP<S B>” on page 16–41.
DMASTZ	Store Zero	No	Yes	Refer to “DMASTZ” on page 16–42.
DMAWFE	Wait For Event	Yes	Yes	Refer to “DMAWFE” on page 16–43.
DMAWFP	Wait For Peripheral	No	Yes	Refer to “DMAWFP” on page 16–43.
DMAWMB	Write Memory Barrier	No	Yes	Refer to “DMAWMB” on page 16–44.

Instructions

The following sections describe the instructions that a DMAC can execute.

DMAADDH

Add Halfword adds an immediate 16-bit value to the SAR_n register or DAR_n register, for the DMA channel thread. This enables the DMAC to support 2D DMA operations.



The immediate unsigned 16-bit value is zero-extended before the DMAC adds it to the address, using 32-bit addition. The DMAC discards the carry bit so that addresses wrap from 0xFFFFFFFF to 0x00000000.

Figure 16-5 shows the instruction encoding.

Figure 16-5. DMAADDH Encoding

23	16	15	8	7	6	5	4	3	2	1	0
imm[15:8]				imm[7:0]				0	1	0	1
								0	1	ra	0

Assembler syntax

DMAADDH <address_register>, <16-bit immediate>

where:

<address_register> Selects the address register to use. It must be either:

SAR SAR_n register and sets ra to 0

DAR DAR_n register and sets ra to 1

<16-bit immediate> The immediate value to be added to the <address_register>.

Operation

You can only use this instruction in a DMA channel thread.

DMAADNH

Add Negative Halfword adds an immediate negative 16-bit value to the SAR_n register or DAR_n register, for the DMA channel thread. This enables the DMAC to support 2D DMA operations, or reading or writing an area of memory in a different order to naturally incrementing addresses.



The immediate unsigned 16-bit value is one-extended to 32 bits, to create a value that is the two's complement representation of a negative number between -65536 and -1, before the DMAC adds it to the address using 32-bit addition. The DMAC discards the carry bit so that addresses wrap from 0xFFFFFFFF to 0x00000000. The net effect is to subtract between 65536 and 1 from the current value in the source or destination address register.

Figure 16-6 shows the instruction encoding.

Figure 16-6. DMAADNH Encoding

23	16	15	8	7	6	5	4	3	2	1	0
imm[15:8]				imm[7:0]				0	1	0	1
								1	1	ra	0

Assembler syntax

DMAADNH <address_register>, <16-bit immediate>

where:

<address_register> Selects the address register to use. It must be either:

SAR SAR_n register and sets ra to 0

DAR DAR_n register and sets ra to 1

<16-bit immediate> The immediate value to be added to the <address_register>.



You should specify the 16-bit immediate as the number that is to be represented in the instruction encoding. For example, DMAADNH DAR, 0xFFFF0 causes the value 0xFFFFFFF0 to be added to the current value of the Destination Address register, effectively subtracting 16 from the DAR.

Operation

You can only use this instruction in a DMA channel thread.

DMAEND

End signals to the DMAC that the DMA sequence is complete. After all DMA transfers are complete for the DMA channel, the DMAC moves the channel to the Stopped state. It also flushes data from the MFIFO buffer and invalidates all cache entries for the thread.

Figure 16-7 shows the instruction encoding.

Figure 16-7. DMAEND Encoding

7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0

Assembler syntax

DMAEND

Operation

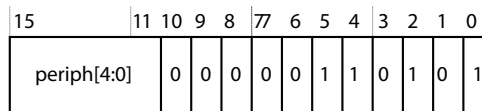
You can use the instruction with the DMA manager thread and the DMA channel thread.

DMAFLUSHP

Flush Peripheral clears the state in the DMAC that describes the contents of the peripheral and sends a message to the peripheral to resend its level status.

Figure 16–8 shows the instruction encoding.

Figure 16–8. DMAFLUSHP Encoding



Assembler syntax

DMAFLUSHP <peripheral>

where:

<peripheral> 5-bit immediate, value 0-31

Operation

You can only use this instruction in a DMA channel thread.

DMAGO

When the DMA manager executes Go for a DMA channel that is in the Stopped state, it performs the following steps on the DMA channel:

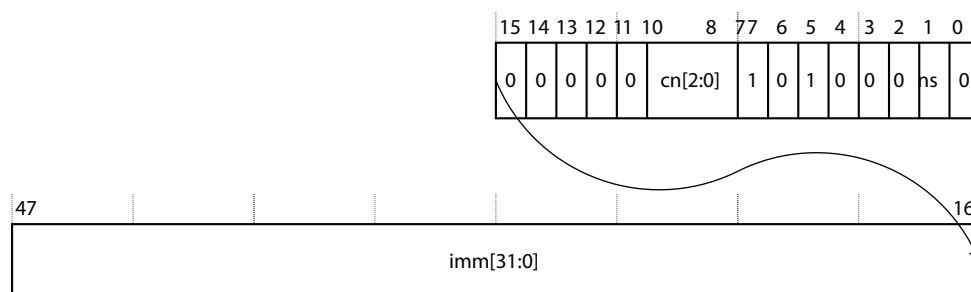
1. Moves a 32-bit immediate into the program counter
2. Sets its security state
3. Updates it to the Executing state.



If a DMA channel is not in the Stopped state when the DMA manager executes DMAGO then the DMAC does not execute DMAGO but instead it executes DMANOP.

Figure 16–9 shows the instruction encoding.

Figure 16–9. DMAGO Encoding



Assembler syntax

DMAGO <channel_number>, <32-bit_immediate> [, ns]

where:

<channel_number> Selects a DMA channel. It must be one of:

- C0 DMA channel 0
- C1 DMA channel 1
- C2 DMA channel 2
- C3 DMA channel 3
- C4 DMA channel 4
- C5 DMA channel 5
- C6 DMA channel 6
- C7 DMA channel 7



If you provide a channel number that is not available for your configuration of the DMAC, the DMA manager thread aborts.

<32-bit_immediate> The immediate value that is written to the CPCn register for the selected <channel_number>.

[ns]

- If ns is present, the DMA channel operates in the Non-secure state.
- Otherwise, the execution of the instruction depends on the security state of the DMA manager:

DMA manager is in the Secure state—DMA channel operates in the Secure state.

DMA manager is in the Non-secure state—The DMAC aborts.

Operation

You can only use this instruction with the DMA manager thread.

DMAKILL

Kill instructs the DMAC to immediately terminate execution of a thread. Depending on the thread type, the DMAC performs the following steps:

DMA Manager Thread

1. Invalidates all cache entries for the DMA manager.
2. Moves the DMA manager to the Stopped state.

DMA Channel Thread

1. Moves the DMA channel to the Killing state.
2. Waits for AXI transactions, with an ID equal to the DMA channel number, to complete.
3. Invalidates all cache entries for the DMA channel.

4. Remove all entries in the MFIFO buffer for the DMA channel.
5. Remove all entries in the read buffer queue and write buffer queue for the DMA channel.
6. Moves the DMA channel to the Stopped state.

Figure 16-10 shows the instruction encoding.

Figure 16-10. DMAKILL Encoding

7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	1

Assembler syntax

DMAKILL

Operation

You can use the instruction with the DMA manager thread and the DMA channel thread.



You must not use the DMAKILL instruction in DMA channel programs. To issue a DMAKILL instruction, use the DBGINST0 register.

DMALD[S | B]

Load instructs the DMAC to perform a DMA load, using AXI transactions that the source address registers and channel control registers specify. It places the read data into the MFIFO buffer and tags it with the corresponding channel number. DMALD is an unconditional instruction but DMALDS and DMALDB are conditional on the state of the request_type flag. If the src_inc bit in the channel control registers is set to incrementing, the DMAC updates the source address registers after it executes DMALD[S | B].



The DMAC sets the value of request_type when it executes a DMAWFP instruction. Refer to “DMAWFP” on page 16-43.

Figure 16-11 shows the instruction encoding.

Figure 16-11. DMALD[S|B] Encoding

7	6	5	4	3	2	1	0
0	0	0	0	0	1	bs	x

Assembler syntax

DMALD[S | B]

where:

[S] If S is present, the assembler sets bs to 0 and x to 1. The instruction is conditional on the state of the request_type flag:

- request_type = Single

The DMAC performs a `DMALD` instruction and it sets `arlen[3:0]=0x0` so that the AXI read transaction length is one. The DMAC ignores the value of the `src_burst_len` field in the channel control registers.

- request_type = Burst

The DMAC performs a `DMANOP` instruction. The DMAC increments the channel PC to the next instruction. No state change occurs.

[B] If B is present, the assembler sets `bs` to 1 and `x` to 1. The instruction is conditional on the state of the `request_type` flag:

- request_type = Single

The DMAC performs a `DMANOP` instruction. The DMAC increments the channel PC to the next instruction. No state change occurs.

- request_type = Burst

The DMAC performs a `DMALD`.

If you do not specify the S or B operand, the assembler sets `bs` to 0 and `x` to 0, and the DMAC always executes a DMA load.

Operation

You can only use this instruction in a DMA channel thread. If you specify the S or B operand, execution of the instruction is conditional on the state of `request_type` matching that of the instruction.

DMALDP<S | B>

Load and notify Peripheral instructs the DMAC to perform a DMA load, using AXI transactions that source address registers and channel control registers specify. It places the read data into a FIFO buffer that is tagged with the corresponding channel number and after it receives the last data item, it sends an acknowledgement to the peripheral that the data transfer is complete. If the `src_inc` bit in the channel control registers is set to incrementing, the DMAC updates source address registers after it executes `DMALDP<S | B>`.

Figure 16-12 shows the instruction encoding.

Figure 16-12. DMALDP<S|B> Encoding

15	11	10	9	8	7	6	5	4	3	2	1	0
periph[4:0]				0	0	0	0	0	1	0	bs	1

Assembler syntax

`DMALDP<S | B> <peripheral>`

where:

<S> When S is present, the assembler sets `bs` to 0. The instruction is conditional on the state of the `request_type` flag:

- request_type = Single

The DMAC performs a `DMALDP` instruction and it sets `arlen[3:0]=0x0` so that the AXI read transaction length is one. The DMAC ignores the value of the `src_burst_len` field in the channel control registers.

- request_type = Burst

The DMAC performs a `DMANOP`.

 When B is present, the assembler sets `bs` to 1. The instruction is conditional on the state of the `request_type` flag:

- request_type = Single

The DMAC performs a `DMANOP`.

- request_type = Burst

The DMAC performs a load using a burst DMA transfer.

<peripheral> 5-bit immediate, value 0-31.



The DMAC sets the value of the `request_type` flag when it executes a `DMAWFP` instruction. Refer to “[DMAWFP](#)” on [page 16-43](#).

Operation

You can only use this instruction in a DMA channel thread. Execution of the instruction is conditional on the state of the `request_type` flag matching that of the instruction.

DMALP

Loop instructs the DMAC to load an 8-bit value into the loop counter register you specify.

This instruction indicates the start of a section of instructions, and you set the end of the section using the `DMALPEND` instruction. Refer to “[DMALPEND\[S | B\]](#)” on [page 16-36](#). The DMAC repeats the set of instructions that you insert between `DMALP` and `DMALPEND` until the value in the loop counter register reaches zero.



The DMAC saves the value of the PC for the instruction that follows `DMALP`. After the DMAC executes `DMALPEND`, and the loop counter register is not zero, this enables it to execute the first instruction in the loop.

[Figure 16-13](#) shows the instruction encoding.

Figure 16-13. DMALP Encoding

15	8	7	6	5	4	3	2	1	0
iter[7:0]		0	0	1	0	0	0	lc	0

Assembler syntax

DMALP <loop_iterations>

where:

<loop_iterations>

Specifies the number of loops to perform, range 1-256.

- The assembler determines the loop counter register to use and either:
 - Sets lc to 0, and the DMAC writes the value loop_iterations minus 1 to the loop counter 0 registers
 - Sets lc to 1, and the DMAC writes the value loop_iterations minus 1 to the loop counter 1 registers.

Operation

You can only use this instruction in a DMA channel thread.

DMALPEND[S | B]

Loop End indicates the last instruction in the program loop but the behavior of the DMAC depends on whether DMALP or DMALPFE starts the loop. If a loop starts with:

- DMALP The loop has a defined loop count and DMALPEND[S|B] instructs the DMAC to read the value of the loop counter register. If a loop counter register returns:
 - Zero—The DMAC executes a DMANOP and therefore exits the loop.
 - Nonzero—The DMAC decrements the value in the loop counter register and updates the thread PC to contain the address of the first instruction in the program loop, that is, the instruction that follows the DMALP.
- DMALPFE The loop has an undefined loop count and the DMAC uses the state of the request_last flag to control when it exits the loop. If the request_last flag is:
 - 0—The DMAC updates the thread PC to contain the address of the first instruction in the program loop, that is, the instruction that follows the DMALP.
 - 1—The DMAC executes a DMANOP and therefore exits the loop.

Figure 16-14 shows the instruction encoding.

Figure 16-14. DMALPEND[S|B] Encoding

15	8	7	6	5	4	3	2	1	0
backwards_jump[7:0]		0	0	1	nf	1	lc	bs	x

Assembler syntax

DMALPEND [S | B]

where:


[S] If S is present and the loop starts with DMALP, then the assembler sets bs to 0 and x to 1. The instruction is conditional on the state of the request_type flag;


- request_type = Single
 - The DMAC executes the DMALPEND.
- request_type = Burst
 - The DMAC performs a DMANOP and therefore exits the loop.

[B] If B is present and the loop starts with DMALP, then the assembler sets bs to 1 and x to 1. The instruction is conditional on the state of the request_type flag:

- request_type = Single
 - The DMAC performs a DMANOP and therefore exits the loop.
- request_type = Burst
 - The DMAC executes the DMALPEND

If you do not specify the S or B operand, the assembler sets bs to 0 and x to 0, and the DMAC always executes the DMALPEND.

 You must not specify the S or B operand when a loop starts with DMALPFE. If you do, the assembler issues a warning message and sets bs to 0, x to 0, and nf to 1. In the same way as for DMALPFE, the DMAC uses the state of the request_last flag to control when it exits the loop.

 The DMAC sets the value of the:

- request_type flag when it executes a DMAWFP instruction. Refer to “DMAWFP” on page 16-43.
- request_last flag to 1 when the corresponding peripheral issues the last request command through the peripheral request interface. For more information, refer to “Peripheral Length Management” on page 16-12.

To correctly assign the additional bits in the DMALPEND instruction, that Figure 16-14 shows, the assembler determines the values for:

backwards_jump[7:0] Sets the relative location of the first instruction in the program loop. The assembler calculates the value for backwards_jump[7:0] by subtracting the address of the first instruction in the loop from the address of the DMALPEND.

- nf sets it to:
 - 0 if DMALPFE started the program loop
 - 1 if DMALP started the program loop.
- lc sets it to:
 - 0 if the loop counter 0 registers contains the loop counter value
 - 1 if the loop counter 1 registers contains the loop counter value
 - 1 if DMALPFE started the program loop.

Operation

You can only use this instruction in a DMA channel thread. If you specify the S or B operand, execution of the instruction is conditional on the state of the request_type flag matching that of the instruction.

DMALPFE

The assembler uses Loop Forever to configure certain bits in DMALPEND. Refer to “DMALPEND[S | B]” on page 16-36.



When the assembler encounters DMALPFE, it does not create an instruction for the DMAC, but instead, it modifies the behavior of DMALPEND. The insertion of DMALPFE in program code identifies the start of the loop.

Assembler syntax

DMALPFE

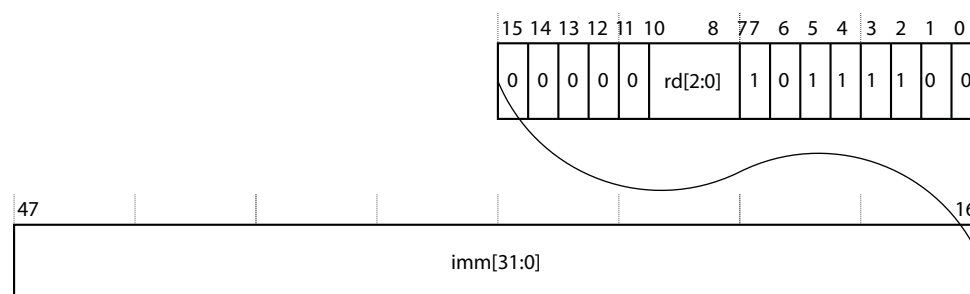
DMAMOV

Move instructs the DMAC to move a 32-bit immediate into the following registers:

- source address registers
- destination address registers
- channel control registers

Figure 16-15 shows the instruction encoding.

Figure 16-15. DMAMOV Encoding



Assembler syntax

DMAMOV <destination_register>, <32-bit_immediate>

where:

<destination_register>

The valid registers are:

- SAR—selects the source address registers and sets rd to b000
- CCR—selects the channel control registers and sets rd to b001
- DAR—selects the destination address registers and sets rd to b010

<32-bit_immediate>

A 32-bit value that is written to the specified destination register.



For information about using the assembler to program the various fields that the channel control registers, refer to “DMAMOV CCR” on page 16-46.

Operation

You can only use this instruction in a DMA channel thread.

DMANOP

No Operation does nothing. You can use this instruction for code alignment purposes.

Figure 16-16 shows the instruction encoding.

Figure 16-16. DMANOP Encoding

7	6	5	4	3	2	1	0
0	0	0	1	1	0	0	0

Assembler syntax

DMANOP

Operation

You can use the instruction with the DMA manager thread and the DMA channel thread.

DMARMB

Read Memory Barrier forces the DMA channel to wait until all of the executed DMALD instructions for that channel have been issued on the AXI master interface and have completed.

This enables write-after-read sequences to the same address location with no hazards.

Figure 16-17 shows the instruction encoding.

Figure 16-17. DMARMB Encoding

7	6	5	4	3	2	1	0
0	0	0	1	0	0	1	0

Assembler syntax

DMARMB

Operation

You can only use this instruction in a DMA channel thread.

DMASEV

Send Event instructs the DMAC to modify an event-interrupt resource. Depending on how you program the interrupt enable register, this either:

- Generates event `<event_num>`



Typically, you use `DMAWFE` to stall a thread and then another thread executes `DMASEV`, using the appropriate event number, to unstall the waiting thread. Refer to “Using an Event to Restart DMA Channels” on page 16-15.

- Signals an interrupt using `irq<event_num>`.

Figure 16-18 shows the instruction encoding.

Figure 16-18. DMASEV Encoding

15	11	10	9	8	7	6	5	4	3	2	1	0
event_num[4:0]	0	0	0	0	0	1	1	0	1	0	0	

Assembler syntax

`DMASEV <event_num>`

where:

`<event_num>` 5-bit immediate, value 0-31



The DMAC aborts the thread if you select an event number that is not available.

Operation

You can use the instruction with the DMA manager thread and the DMA channel thread. For more information, refer to “Using Events and Interrupts” on page 16-15.

DMAST[S | B]

Store instructs the DMAC to transfer data from the FIFO buffer to the location that the destination address registers specifies, using AXI transactions that the DA register and channel control registers specify. If the `dst_inc` bit in the channel control registers is set to incrementing, the DMAC updates the destination address registers after it executes `DMAST[S | B]`.

Figure 16-19 shows the instruction encoding.

Figure 16-19. DMAST[S|B] Encoding

7	6	5	4	3	2	1	0
0	0	0	0	1	0	ps	x

Assembler syntax

DMAST[S | B]

where:

[S] If S is present, the assembler sets bs to 0 and x to 1. The instruction is conditional on the state of the request_type flag:

- request_type = Single
 - The DMAC performs a DMAST instruction and it sets awlen[3:0]=0x0 so that the AXI write transaction length is one. The DMAC ignores the v value of the dst_burst_len field in the channel control registers.
- request_type = Burst
 - The DMAC performs a DMANOP instruction. The DMAC increments the channel PC to the next instruction. No state change occurs.

[B] If B is present, the assembler sets bs to 1 and x to 1. The instruction is conditional on the state of the request_type flag:

- request_type = Single
 - The DMAC performs a DMANOP instruction. The DMAC increments the channel PC to the next instruction. No state change occurs.
- request_type = Burst
 - The DMAC performs a DMAST.
 - If you do not specify the S or B operand, the assembler sets bs to 0 and x to 0, and the DMAC always executes a DMA store.



The DMAC sets the value of the request_type flag when it executes a DMAWFP instruction. Refer to “DMAWFP” on page 16-43.

Operation

You can only use this instruction in a DMA channel thread. If you specify the S or B operand, execution of the instruction is conditional on the state of the request_type flag matching that of the instruction.

The DMAC only commences the burst when the MFIFO buffer contains all of the data necessary to complete the burst transfer.

DMASTP<S | B>

Store and notify Peripheral instructs the DMAC to transfer data from the FIFO buffer to the location that the destination address registers specifies, using AXI transactions that the DA register and channel control registers specify. It uses the DMA channel number to access the appropriate location in the FIFO buffer. After the DMA store is complete, and the DMAC has received a buffered write response, it issues an acknowledgement to the peripheral that the data transfer is complete. If the dst_inc bit in the channel control registers is set to incrementing, the DMAC updates the destination address registers after it executes DMASTP<S | B>.

Figure 16-20 shows the instruction encoding.

Figure 16-20. DMASTP<S|B> Encoding

15	11	10	9	8	7	6	5	4	3	2	1	0
periph[4:0]					0	0	0	0	0	1	0	bs


Assembler syntax

DMASTP<S | B> <peripheral>

where:

<S> Sets bs to 0. This instructs the DMAC to perform:

- A single DMA store operation if request_type is programmed to Single


 The DMAC ignores the state of the dst_burst_len field in the channel control registers and always performs an AXI transfer with a burst length of one.

- A DMANOP if request_type is programmed to Burst.

 Sets bs to 1. This instructs the DMAC to perform:

- The DMA store if request_type is programmed to Burst
- A DMANOP if request_type is programmed to Single.

<peripheral> 5-bit immediate, value 0-31.

 The DMAC sets the value of the request_type flag when it executes a DMAWFP instruction. Refer to “DMAWFP” on page 16-43.

Operation

You can only use this instruction in a DMA channel thread.

The DMAC only commences the burst when the MFIFO buffer contains all of the data necessary to complete the burst transfer.

DMASTZ

Store Zero instructs the DMAC to store zeros, using AXI transactions that the destination address registers and channel control registers specify. If the dst_inc bit in the channel control registers is set to incrementing, the DMAC updates the destination address registers after it executes DMASTZ.

Figure 16-21 shows the instruction encoding.

Figure 16-21. DMASTZ Encoding

7	6	5	4	3	2	1	0
0	0	0	0	1	1	0	0

Assembler syntax

DMASTZ

Operation

You can only use this instruction in a DMA channel thread.

DMAWFE

Wait For Event instructs the DMAC to halt execution of the thread until the event, that *<event_num>* specifies, occurs. When the event occurs, the thread moves to the Executing state and the DMAC clears the event. Refer to “Using Events and Interrupts” on page 16-15.

Figure 16-22 shows the instruction encoding.

Figure 16-22. DMAWFE Encoding

15	11	10	9	8	7	6	5	4	3	2	1	0
event_num[4:0]	0	i	0	0	0	1	1	0	1	1	0	

Assembler syntax

DMAWFE <event_num>[, invalid]

where:

<event_num> 5-bit immediate, value 0-31

[invalid] Sets *i* to 1. If *invalid* is present, the DMAC invalidates the instruction cache for the current DMA thread. If *invalid* is not present, then the assembler sets *i* to 0 and the DMAC does not invalidate the instruction cache for the current DMA.



The DMAC aborts the thread if you select an event number that is not available for your configuration of the DMAC.

To ensure cache coherency, you must use *invalid* when a processor writes the instruction stream for a DMA channel.

Operation

You can use the instruction with the DMA manager thread and the DMA channel thread.

DMAWFP

Wait For Peripheral instructs the DMAC to halt execution of the thread until the specified peripheral signals a DMA request for that DMA channel.

Figure 16-23 shows the instruction encoding.

Figure 16-23. DMAWFP Encoding

15	11	10	9	8	7	6	5	4	3	2	1	0
peripheral[4:0]	0	0	0	0	0	1	1	0	0	bs	p	

Assembler syntax

DMAWFP <peripheral>, <single|burst|periph>

where:

<peripheral> 5-bit immediate, value 0-31



The DMAC aborts the thread if you select a peripheral number that is not available.

<single> Sets bs to 0 and p to 0. This instructs the DMAC to continue executing the DMA channel thread after it receives a single or burst DMA request. The DMAC sets the request_type to Single, for that DMA channel.

<burst> Sets bs to 1 and p to 0. This instructs the DMAC to continue executing the DMA channel thread after it receives a burst DMA request. The DMAC sets the request_type to Burst.



The DMAC ignores single burst DMA requests.

<periph> Sets bs to 0 and p to 1. This instructs the DMAC to continue executing the DMA channel thread after it receives a single or burst DMA request. The DMAC sets the request_type to:

Single When it receives a single DMA request.

Burst When it receives a burst DMA request.

Operation

You can only use this instruction in a DMA channel thread.

DMAWMB

Write Memory Barrier forces the DMA channel to wait until all of the executed DMAST instructions for that channel have been issued on the AXI master interface and have completed.

This permits read-after-write sequences to the same address location with no hazards.

Figure 16-24 shows the instruction encoding.

Figure 16-24. DMAWMB Encoding

7	6	5	4	3	2	1	0
0	0	0	1	0	0	1	1

Assembler syntax

DMAWMB

Operation

You can only use this instruction in a DMA channel thread.

Assembler Directives

The assembler provides the following additional commands:

- DCD
- DCB
- DMALP
- DMALPFE
- DMAMOV CCR

DCD

Assembler directive to place a 32-bit immediate in the instruction stream.

Syntax

DCD imm32

DCB

Assembler directive to place an 8-bit immediate in the instruction stream.

Syntax

DCB imm8

DMALP

Assembler directive to insert an iterative loop.

Syntax

DMALP [<LC0>|<LC1>] <loop_iterations>

where:

<loop_iterations>

An 8-bit value that specifies the number of loops to perform.



For clarity in writing assembler instructions, the 8-bit value is the actual number of iterations of the loop to be executed. The assembler decrements this by one to create the actual value, 0-255, that the DMAC uses.

[LC0] If LC0 is present, the DMAC stores <loop_iterations> in the loop counter 0 registers.

[LC1] If LC1 is present, the DMAC stores <loop_iterations> in the loop counter 1 registers.

 If LC0 or LC1 is not present, the assembler determines the loop counter register to use.

DMALPFE

Assembler directive to insert a repetitive loop.

Syntax

DMALPFE

Enables the assembler to clear the `nf` bit that is present in `DMALPEND`. Refer to “`DMALPEND[S | B]`” on page 16-36.

DMAMOV CCR

Assembler directive that enables you to program the channel control registers using the specified format.

Syntax

```
DMAMOV CCR,
    [SB<1-16>] [SS<8|16|32|64|128>] [SA<I|F>]
    [SP<imm3>] [SC<imm4>]
    [DB<1-16>] [DS<8|16|32|64|128>] [DA<I|F>]
    [DP<imm3>] [DC<imm4>]
    [ES<8|16|32|64|128>]
```

Table 16-3 shows the argument descriptions and the default values.

Table 16-3. DMAMOV CCR argument description and the default values

Syntax	Description	Options	Default
SA	Source address increment. Sets the value of <code>arburst[0]</code>	I = Increment F = Fixed	I
SS	Source burst size in bits. Sets the value of <code>arsize[2:0]</code>	8, 16, 32, or 64	8
SB	Source burst length. Sets the value of <code>arlen[3:0]</code>	1 to 16	1
SP	Source protection	0 to 7 ⁽¹⁾	0
SC	Source cache	0 to 15 ⁽¹⁾ ⁽²⁾	0
DA	Destination address increment. Sets the value of <code>awburst[0]</code>	I = Increment F = Fixed	I
DS	Destination burst size in bits. Sets the value of <code>awsize[2:0]</code>	8, 16, 32, or 64	8
DB	Destination burst length. Sets the value of <code>awlen[3:0]</code>	1 to 16	1
DP	Destination protection	0 to 7 ⁽¹⁾	0
DC	Destination cache	0 to 15 ⁽¹⁾ ⁽³⁾	0
ES	Endian swap size, in bits	8, 16, 32, or 64	8

Notes to Table 16-3:

- (1) You must use decimal values when programming this immediate value
- (2) Because the DMAC ties `ARCACHE[3]` LOW, the assembler always sets bit 3 to 0 and uses bits [2:0] of your chosen value for SC.
- (3) Because the DMAC ties `AWCACHE[2]` LOW, the assembler always sets bit 2 to 0 and uses bit [3] and bits [1:0] of your chosen value for DC.

MFIFO Buffer Usage Overview

This section shows MFIFO buffer usage for some example DMA channel programs.

About MFIFO Buffer Usage Overview

The MFIFO buffer is a shared resource that is utilized on a first-come, first-served basis by all currently active channels. To a program, it appears as a set of variable-depth parallel FIFO buffers, one per channel, with the restriction that the total depth of all the Fives cannot exceed the buffer depth, 512. The width of the AXI master interface is the same as the MFIFO buffer width.

The DMAC is capable of realigning data from the source to the destination. For example, the DMAC shifts the data by two byte lanes when it reads a word from address 0x103 and writes to address 0x205. All byte manipulations occur when data enters the MFIFO buffer, as a result of an AXI read due to a `DMALD` instruction, so that the DMAC does not need to manipulate the data when it removes it from the MFIFO buffer, as a result of an AXI write due to a `DMAST` instruction. Therefore the storage and packing of the data in the MFIFO buffer is determined by the destination address and transfer characteristics.

When a program specifies that incrementing transactions are to be performed to the destination, the DMAC packs data into the MFIFO buffer to minimize the usage of the MFIFO buffer entries. For example, the DMAC packs two 32-bit words into a single entry in the MFIFO buffer when the DMAC has a 64-bit AXI data bus and the program uses a source address of 0x100, and destination address of 0x200.

In certain situations, the number of entries required to store the data loaded from a source is not a simple calculation of amount of source data divided by MFIFO buffer width. The calculation of the number of entries required is not simple when any of the following occur:

- The source address is not aligned to the AXI bus width.
- The destination address is not aligned to the AXI bus width.
- The transactions are to a fixed destination, that is, a non-incrementing address.

The `DMALD` and `DMAST` instructions each specify that an AXI transaction is to be performed. The amount of data transferred by an AXI transaction depends on the values programmed in to the `CCRn` register and the address of the transaction.



For information about unaligned transfers, refer to the *AMBA AXI Protocol Specification v1.0*, available from the ARM website (infocenter.arm.com).

The following sections provide several example DMAC programs together with illustrations of the MFIFO buffer usage.



These sections show MFIFO buffer usage in the following ways:

- a graph of the number of MFIFO buffer entries versus time
- a diagram of the byte-lane manipulation that the DMAC performs when data enters the MFIFO buffer.



The numbers 0 and 7 in the MFIFO buffer diagrams indicate the byte lanes in the MFIFO buffer.

Aligned Transfers

The following sections show examples of aligned transfers.

Simple Aligned Program

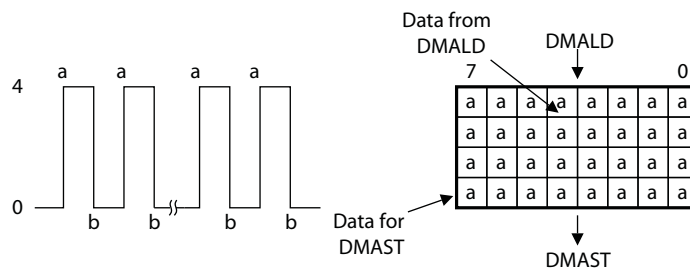
In this program, the source address and destination address are aligned with the AXI data bus width.

Example 16-2. Simple Aligned Program

```
DMAMOV CCR, SB4 SS64 DB4 DS64
DMAMOV SAR, 0x1000
DMAMOV DAR, 0x4000
DMALP 16
DMALD ; shown as a in Figure 16-25
DMAST ; shown as b in Figure 16-25
DMALPEND
DMAEND
```

Figure 16-25 shows the MFIFO buffer usage for this program.

Figure 16-25. Simple Aligned Program



In Figure 16-25, each DMALD requires four entries and each DMAST removes four entries.

This example has a static requirement of zero MFIFO buffer entries and a dynamic requirement of four MFIFO buffer entries.

Aligned Asymmetric Program with Multiple Loads

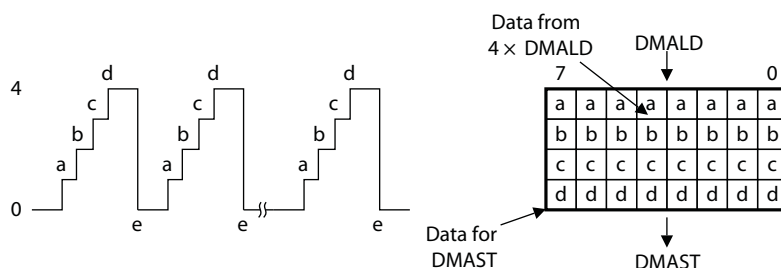
The following program performs four loads for each store and the source address and destination address are aligned with the AXI data bus width.

Example 16-3. Aligned Asymmetric Program with Multiple Loads

```
DMAMOV CCR, SB1 SS64 DB4 DS64
DMAMOV SAR, 0x1000
DMAMOV DAR, 0x4000
DMALP 16
DMALD ; shown as a in Figure 16-26
DMALD ; shown as b in Figure 16-26
DMALD ; shown as c in Figure 16-26
DMALD ; shown as d in Figure 16-26
DMAST ; shown as e in Figure 16-26
DMALPEND
DMAEND
```

Figure 16-26 shows the MFIFO buffer usage for this program.

Figure 16-26. Aligned Asymmetric Program with Multiple Loads



In Figure 16-26, each DMALD requires one entry and each DMAST removes four entries. This example has a static requirement of zero MFIFO buffer entries and a dynamic requirement of four MFIFO buffer entries.

Aligned Asymmetric Program with Multiple Stores

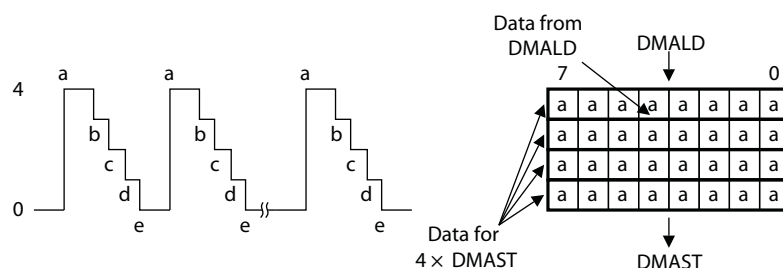
The following program performs four stores for each load and the source address and destination address are aligned with the AXI data bus width.

Example 16-4. Aligned Asymmetric Program with Multiple Stores

```
DMAMOV CCR, SB4 SS64 DB1 DS64
DMAMOV SAR, 0x1000
DMAMOV DAR, 0x4000
DMALP 16
DMALD ; shown as a in Figure 16-27
DMAST ; shown as b in Figure 16-27
DMAST ; shown as c in Figure 16-27
DMAST ; shown as d in Figure 16-27
DMAST ; shown as e in Figure 16-27
DMALPEND
DMAEND
```

Figure 16-27 shows the MFIFO buffer usage for this program.

Figure 16-27. Aligned Asymmetric Program with Multiple Stores



In Figure 16-27, each DMALD requires four entries and each DMAST removes one entry. This example has a static requirement of zero MFIFO buffer entries and a dynamic requirement of four MFIFO buffer entries.

Unaligned Transfers

The following sections show examples of unaligned transfers.

Aligned Source Address to Unaligned Destination Address

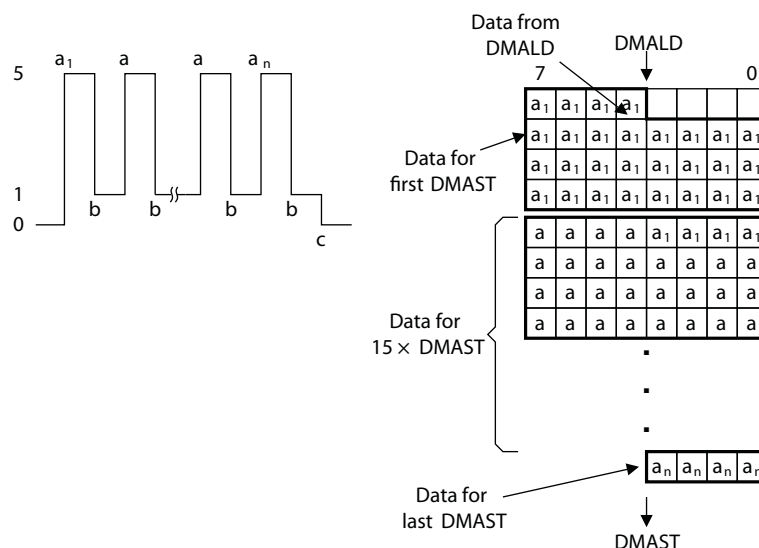
In this program, the source address is aligned with the AXI data bus width but the destination address is unaligned. The destination address is not aligned to the destination burst size so the first DMAST instruction removes less data than the first DMALD instruction reads. Therefore, a final DMAST of a single word is required to clear the data from the MFIFO buffer.

Example 16-5. Aligned Source Address to Unaligned Destination Address

```
DMAMOV CCR, SB4 SS64 DB4 DS64
DMAMOV SAR, 0x1000
DMAMOV DAR, 0x4004
DMALP 16
DMALD ; shown as a1, ... a, an in Figure 16-28
DMAST ; shown as b in Figure 16-28
DMALPEND
DMAMOV CCR, SB4 SS64 DB1 DS32
DMAST ; shown as c in Figure 16-28
DMAEND
```

Figure 16-28 shows the MFIFO buffer usage for this program.

Figure 16-28. Aligned to Unaligned Program



The first DMALD instruction loads four doublewords but because the destination address is unaligned, the DMAC shifts them by four bytes and therefore it uses five entries in the MFIFO buffer.

Each DMAST requires only four entries of data and therefore the extra entry remains in use for the duration of the program until it is emptied by the last DMAST.

This example has a static requirement of one MFIFO buffer entry and a dynamic requirement of four MFIFO buffer entries.

Unaligned Source Address to Aligned Destination Address

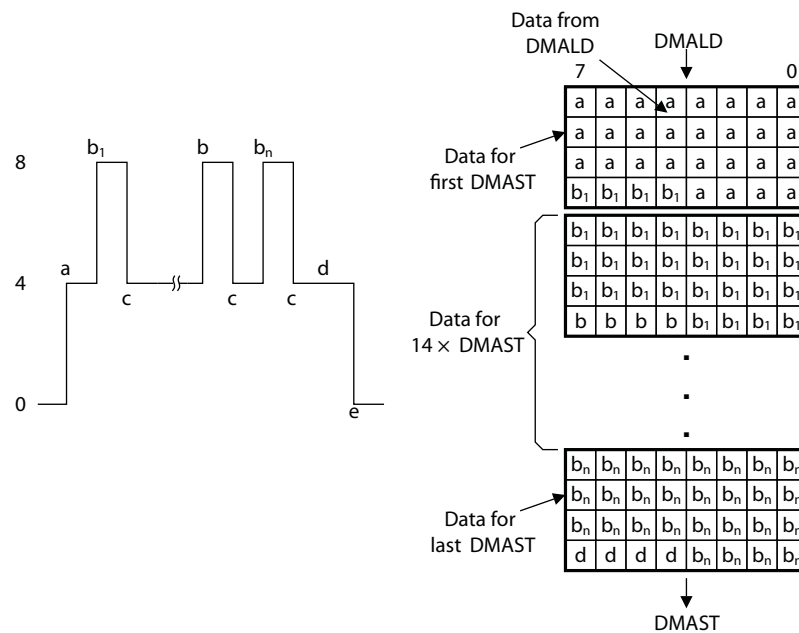
In this program, the source address is unaligned with the AXI data bus width but the destination address is aligned. The source address is not aligned to the source burst size so the first DMALD instruction reads in less data than the DMAST. Therefore, an extra DMALD is required to satisfy the first DMAST.

Example 16-6. Unaligned Source Address to Aligned Destination Address

```
DMAMOV CCR, SB4 SS64 DB4 DS64
DMAMOV SAR, 0x1004
DMAMOV DAR, 0x4000
DMALD ; shown as a in Figure 16-29
DMALP 15
DMALD ; shown as b1, ... b, bn in Figure 16-29
DMAST ; shown as c in Figure 16-29
DMALPEND
DMAMOV CCR, SB1 SS32 DB4 DS64
DMALD ; shown as d in Figure 16-29
DMAST ; shown as e in Figure 16-29
DMAEND
```

Figure 16-29 shows the MFIFO buffer usage for this program.

Figure 16-29. Unaligned to Aligned Program



The DMALD shown as **d** does not increase the MFIFO buffer usage because it loads four bytes into an MFIFO buffer entry that the DMAC has already allocated to this channel.

The first DMALD instruction does not load sufficient data to enable the DMAC to execute a DMAST and therefore the program includes an additional DMALD, prior to the start of the loop. After the first DMALD, the subsequent DMALDs align with the source burst size. This optimizes the performance but it requires a larger number of MFIFO buffer entries.

This example has a static requirement of four MFIFO buffer entries and a dynamic requirement of four MFIFO buffer entries.

Unaligned Source Address to Aligned Destination Address with Excess Initial Load

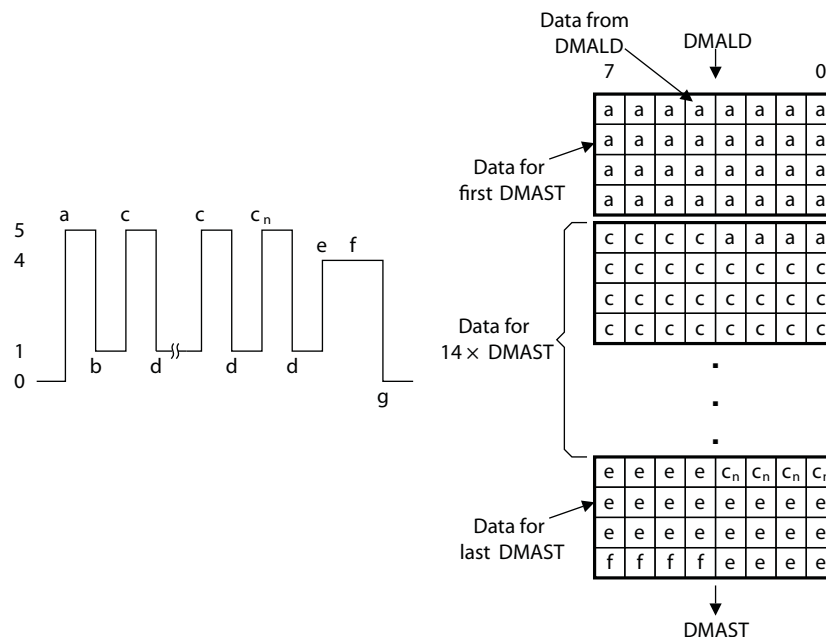
This program is an alternative to that described in “Unaligned Source Address to Aligned Destination Address” on page 16-51. The program uses a different sequence of source bursts which might be less efficient but requires fewer MFIFO buffer entries.

Example 16-7. Unaligned Source Address to Aligned Destination Address with Excess Initial Load

```
DMAMOV CCR, SB5 SS64 DB4 DS64
DMAMOV SAR, 0x1004
DMAMOV DAR, 0x4000
DMALD ; shown as a in Figure 16-30
DMAST ; shown as b in Figure 16-30
DMAMOV CCR, SB4 SS64 DB4 DS64
DMALP 14
DMALD ; shown as c and cn in Figure 16-30
DMAST ; shown as d in Figure 16-30
DMALPEND
DMAMOV CCR, SB3 SS64 DB4 DS64
DMALD ; shown as e in Figure 16-30
DMAMOV CCR, SB1 SS32 DB4 DS64
DMALD ; shown as f in Figure 16-30
DMAST ; shown as g in Figure 16-30
DMAEND
```

Figure 16-30 shows the MFIFO buffer usage for this program.

Figure 16-30. Unaligned to Aligned with Excess Initial Load



The DMALD shown as f does not increase the MFIFO buffer usage because it loads four bytes into an MFIFO buffer entry that the DMAC has already allocated to this channel.

The first DMALD instruction loads five beats of data to enable the DMAC to execute the first DMAST.

After the first DMALD, the subsequent DMALDs are not aligned to the source burst size, for example the second DMALD reads from address 0x1028. After the loop, the final two DMALDs read the data required to satisfy the final DMAST.

This example has a static requirement of one MFIFO buffer entry and a dynamic requirement of four MFIFO buffer entries.

Aligned Burst Size Unaligned MFIFO Buffer

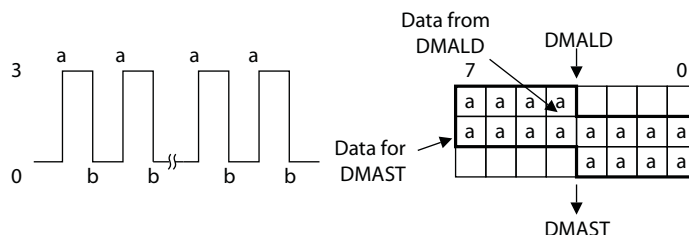
In this program, the destination address, which is narrower than the MFIFO buffer width, aligns with the burst size but does not align with the MFIFO buffer width.

Example 16-8. Aligned Burst Size Unaligned MFIFO Buffer

```
DMAMOV CCR, SB4 SS32 DB4 DS32
DMAMOV SAR, 0x1000
DMAMOV DAR, 0x4004
DMALP 16
DMALD ; shown as a in Figure 16-31
DMAST ; shown as b in Figure 16-31
DMALPEND
DMAEND
```

Figure 16-31 shows the MFIFO buffer usage for this program.

Figure 16-31. Aligned Burst with Unaligned MFIFO Buffer Width



In this example, the destination address is not 64-bit aligned, it requires three rather than the expected two MFIFO buffer entries.

This example has a static requirement of zero MFIFO buffer entries and a dynamic requirement of three MFIFO buffer entries.

Fixed Transfers

The following section shows an example of a fixed destination with aligned address.

Fixed Destination with Aligned Address

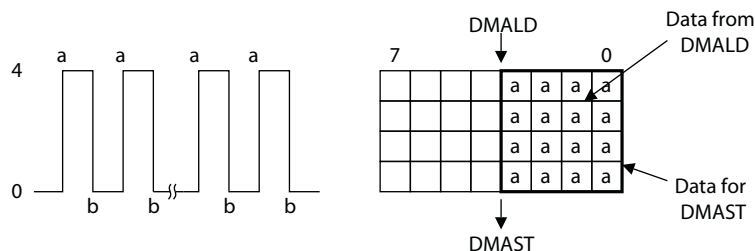
In this program, the source address and destination address are aligned with the AXI data bus width, and the destination address is fixed.

Example 16-9. Fixed Destination with Aligned Address

```
DMAMOV CCR, SB2 SS64 DB4 DS32 DAF
DMAMOV SAR, 0x1000
DMAMOV DAR, 0x4000
DMALP 16
DMALD ; shown as a in Figure 16-32
DMAST ; shown as b in Figure 16-32
DMALPEND
DMAEND
```

Figure 16-32 shows the MFIFO buffer usage for this program.

Figure 16-32. Fixed Destination with Aligned Address



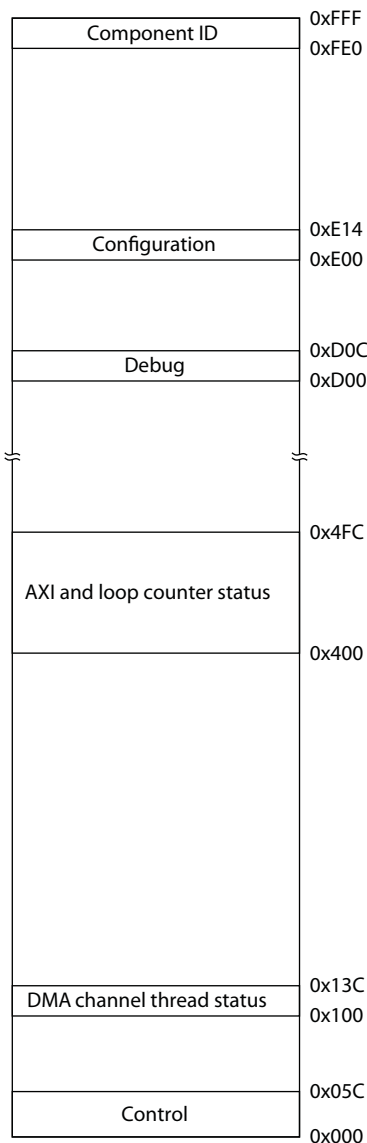
Each DMALD in the program loads two 64-bit data transfers into the MFIFO buffer. Because the destination address is a 32-bit fixed address then the DMAC splits each 64-bit data item across two entries in the MFIFO buffer.

This example has a static requirement of zero MFIFO buffer entries and a dynamic requirement of four MFIFO buffer entries.

DMA Controller Registers

The register map of the DMAC spans a 4 KB region as shown in [Figure 16-33](#).

Figure 16-33. DMAC Summary Register Map




In [Figure 16-33](#), the register map consists of the following sections.

- Control registers—allow you to control the DMAC.
- DMA channel thread status registers—provide the status of the DMA channel threads.
- AXI and loop counter status registers—provide the AXI transfer status and the loop counter status, for each DMA channel thread.

- Debug registers—enable the following functionality:
 - Allows you to send instructions to a thread when debugging the program code.
 - Allows system firmware to send instructions to the DMA manager thread, as “Issuing Instructions to the DMAC using a Slave Interface” on page 16-9 describes.
- Configuration registers—enable system firmware to discover the configuration of the DMAC and control the behavior of the watchdog.
- Component ID registers— enable system firmware to identify peripherals. Do not attempt to access reserved or unused address locations. Attempting to access these locations can result in unpredictable behavior.


Address Map and Register Definitions

 The address map and register definitions reside in the [hps.html](#) file that accompanies this handbook volume. Click the link to open the file.

To view the module description and base address, scroll to and click the following links for the module instance:

- **dmanonsecure**
- **dmasecure**

To then view the register and field descriptions, scroll to and click the register names. The register addresses are offsets relative to the base address of each module instance.

 The base addresses of all modules are also listed in the *Introduction to the Hard Processor System* chapter in volume 3 of the *Cyclone V Device Handbook*.

Document Revision History

Table 16-4 shows the revision history for this document.


Table 16-4. Document Revision History

Date	Version	Changes
November 2012	1.1	Minor updates.
January 2012	1.0	Initial release.

The hard processor system (HPS) provides two Ethernet media access controller (EMAC) peripherals. Each EMAC can be used to transmit and receive data at 10/100/1000 Mbps over Ethernet connections in compliance with the IEEE 802.3 specification. The EMACs are instances of the Synopsys® DesignWare® 3504-0 Universal 10/100/1000 Ethernet MAC (DWC_gmac).

The EMAC has an extensive memory-mapped control and status register (CSR) set, which can be accessed by the ARM Cortex™-A9® MPCore™.

For an understanding of this chapter, you should be familiar with the basics of IEEE 802.3 media access control (MAC).

 For complete information about IEEE 802.3 MAC, refer to *IEEE Std 802.3-2008 Part 3: Carrier sense multiple access with Collision Detection (CSMA/CD) Access Method and Physical Layer Specifications*, available on the IEEE website (standards.ieee.org/findstds/).

Features of the Ethernet MAC

Here is a summary of the features supported by the EMAC peripheral.

MAC

- IEEE 802.3-2008 compliant
- Data rates of 10/100/1000 Mbps
- Full duplex and half duplex modes
- IEEE 802.3x flow control automatic transmission of zero-quanta pause frame on flow control input deassertion
- Optional forwarding of received pause control frames to the user
- Packet bursting and frame extension in 1000 Mbps half-duplex
- IEEE 802.3x flow control in full-duplex
- Back-pressure support for half-duplex
- IEEE 1588-2002 and IEEE 1588-2008 precision networked clock synchronization
- IEEE 802.3-az, version D2.0 for Energy Efficient Ethernet (EEE)
- IEEE 802.1Q virtual local area network (VLAN) tag detection for reception frames

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†Paragraphs marked with the dagger (†) symbol are Synopsys Proprietary. Used with permission.



- Preamble and start-of-frame data (SFD) insertion in transmit and deletion in receive paths
- Automatic cyclic redundancy check (CRC) and pad generation controllable on a per-frame basis
- Options for automatic pad/CRC stripping on receive frames
- Programmable frame length supporting standard and jumbo Ethernet frames (with size up to 16 KB)
- Programmable inter-frame gap (IFG), from 40 to 96 bit times in steps of 8

PHY Interface

- Reduced Gigabit Media Independent Interface (RGMII) for 10/100/1000
- Management Data Input/Output (MDIO) (IEEE 802.3) or I²C PHY management interface

DMA Interface

- 32-bit interface
- Programmable burst size for optimal bus utilization
- Single-channel mode transmit and receive engines
- Byte-aligned addressing mode for data buffer support
- Dual-buffer (ring) or linked-list (chained) descriptor chaining
- Descriptors can each transfer up to 8 KB of data

Management Interface

- 32-bit host interface to CSR set
- Comprehensive status reporting for normal operation and transfers with errors
- Configurable interrupt options for different operational conditions
- Per-frame transmit/receive complete interrupt control
- Separate status returned for transmission and reception packets

Acceleration

- Transmit and receive checksum offload for transmission control protocol (TCP), user datagram protocol (UDP), or Internet control message protocol (ICMP) over Internet protocol (IP)

Other Features

- Supports a variety of flexible address filtering modes
- Up to 31 additional 48-bit perfect destination address (DA) filters with masks for each byte
- Up to 31 48-bit source address (SA) comparison check with masks for each byte

Table 17-1. External PHY Data Interface (Part 2 of 2)

EMAC Port	I/O	Width	Description
rst_clk_tx_n_o	Out	1	Transmit clock reset output.
clk_rx_i	In	1	Receive clock. Clock frequency is 125/25/2.5 MHz in 1G/100M/10Mbps modes. It is provided by the external PHY. All PHY signals received by the EMAC are synchronous to this clock.
phy_rxd_i	In	8	PHY Receive Data. This is a bundle of eight data signals received from the PHY. RGMII: Bits [3:0] provide the RGMII receive data. The data bus is sampled with both rising and falling edges of the receive clock (clk_rx_i). The validity of the data is qualified with phy_rxdv_i. Synchronous to: clk_rx_i, clk_rx_180_i
phy_rxdv_i	In	1	PHY Receive Data Valid. This signal is driven by PHY. RGMII: This is the receive control signal used to qualify the data received on phy_rxd. This signal is sampled on both edges of the clock. Synchronous to: clk_rx_i, clk_rx_180_i
rst_clk_rx_n_o	Out	1	Receive clock reset output.
phy_intf_sel_i[1:0]	In	2	PHY Interface Select: These pins select one of the PHY interfaces of the EMAC. This is sampled only during reset assertion and ignored after that. ■ 01: RGMII ■ 00, 10, and 11: Invalid
clk_ref_i	In	1	This is the reference clock to the EMAC. The clock is emac0_clk or emac1_clk supplied by the clock manager. The system manager drives the phy_intf_sel signal to control which clock is used. The clock rate is 250 MHz.

PHY Management Interface

The HPS can provide support for either MDIO or I²C PHY management interfaces.

MDIO Interface

The MDIO interface signals are synchronous to l4_mp_clk in all supported modes.

Table 17-2. PHY MDIO Management Interface

Signal	I/O	Width	Description
gmii_mdi_i	In	1	Management Data In. The PHY generates this signal to transfer register data during a read operation. This signal is driven synchronously with the gmii_mdc_o clock.
gmii_mdo_o	Out	1	Management Data Out. The EMAC uses this signal to transfer control and data information to the PHY.

Table 17–2. PHY MDIO Management Interface

Signal	I/O	Width	Description
gmii_mdo_o_e	Out	1	Management Data Output Enable. This enable signal drives the gmii_mdo_o signal from an external three-state I/O buffer. This signal is asserted whenever valid data is driven on the gmii_mdo_o signal. The active state of this signal is high.
gmii_mdco_o	Out	1	Management Data Clock. The EMAC provides timing reference for the gmii_mdio_i and gmii_mdo_o signals on MII through this aperiodic clock. The maximum frequency of this clock is 2.5 MHz. This clock is generated from the application clock through a clock divider.

I²C External PHY Management Interface

Some PHY devices use the I²C instead of MDIO for their control interface. Small form factor pluggable (SFP) optical or pluggable modules are often among those with this interface.

The HPS can use two of the four general purpose I²C peripherals for controlling the PHY devices.

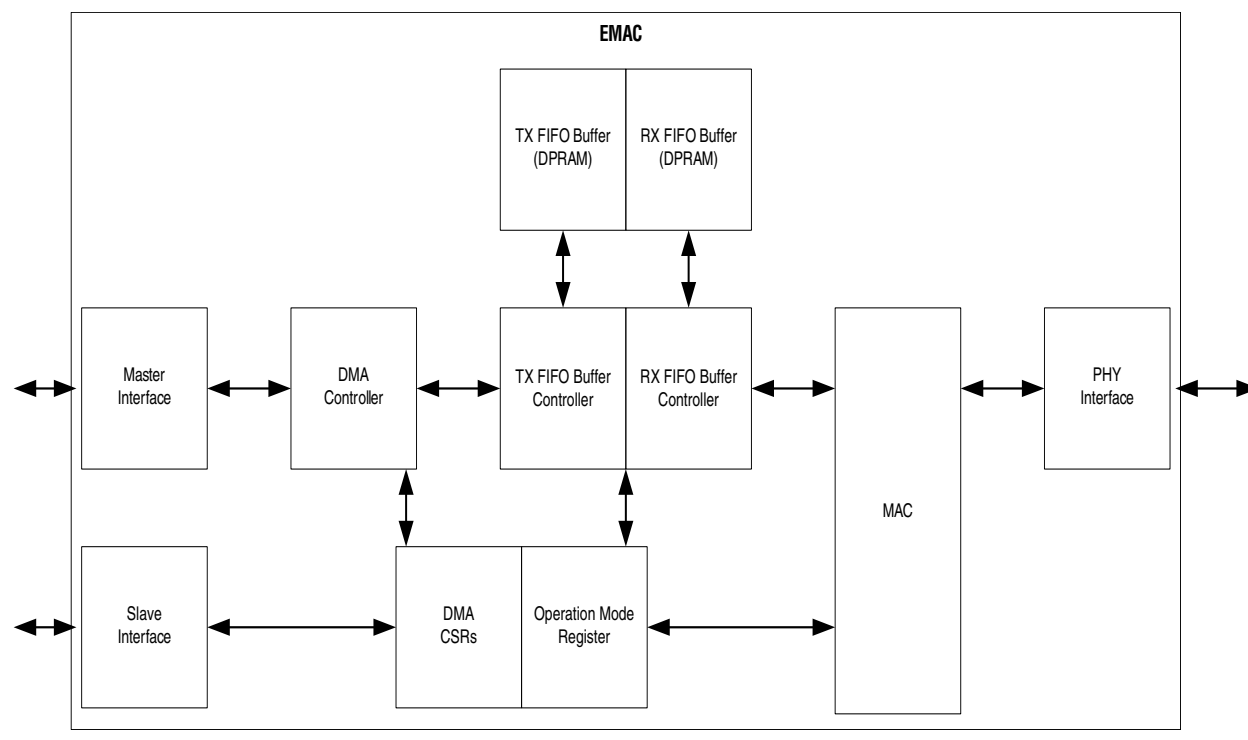
IEEE 1588

The EMAC supports IEEE 1588 operation in all modes with a resolution of one μ s. It can be used by the ARM[®] Cortex[™]-A9 microprocessor unit (MPU) subsystem to maintain synchronization between the time counters internal to the two MACs.

Functional Description of the EMAC

Figure 17-2 illustrates a high level block diagram of the EMAC with its interfaces.

Figure 17-2. EMAC Block Diagram



There are two host interfaces to the MAC. The management host interface, a 32-bit slave interface, provides access to the CSR set. The data interface is a 32-bit interface. It controls data transfer between the direct memory access (DMA) controller channels and the rest of the HPS system through the NIC-301 L3 interconnect.

There is a built-in DMA controller which is optimized for data transfer between the MAC controller and system memory. The DMA controller has independent transmit and receive engines, and a CSR set. The transmit engine transfers data from system memory to the device port, while the receive engine transfers data from the device port to the system memory. The controller uses descriptors to efficiently move data from source to destination with minimal host intervention.

The EMAC also contains FIFO buffer memory to buffer and regulate the Ethernet frames between the application system memory and the EMAC controller. On transmit, the Ethernet frames read into the transmit FIFO buffer (1024 x 42 bits), and eventually trigger the MAC to perform the transfer. Received Ethernet frames are stored in the receive FIFO buffer, also indicating the FIFO buffer fill level to the DMA controller. The DMA controller then initiates the configured burst transfers. Both receive and transmit transfer status are taken from the MAC and transferred to the DMA.

Host Interfaces

There are two host interfaces in the EMAC: a slave and a master. The master is connected to the L3 master peripheral switch interface in the L3 interconnect block.

Slave

The EMAC CSR set access is provided by a slave interface. The slave is connected to the level 4 (L4) bus.

Master

The DMA interface is provided by a master interface. Two types of data are transferred on the interface: data descriptors and actual data packets. The interface is very efficient in transferring full duplex Ethernet packet traffic. Read and write data transfers from different DMA channels can be performed simultaneously on this port. The only exceptions to this are transmit descriptor reads and write-backs which cannot happen simultaneously.

DMA transfers are split into a software configurable number of burst transactions on the interface. The `AXI_Bus_Mode` register in the `dmagrp` group is used to configure bursting behavior.

The interface assigns a unique ID for each DMA channel and also for each read DMA or write DMA request in a channel. Data transfers with distinct IDs can be reordered and interleaved.

Write data transfers are generally performed as posted writes with OK responses returned as soon as the interconnect has accepted the last beat of a data burst. Descriptors (status or timestamp) however are always transferred as non-posted writes in order to prevent race conditions with the transfer complete interrupt logic.

The slave may issue an error response. When that happens, the EMAC disables the DMA channel which generated the original request and asserts an interrupt signal. The host needs to reset the EMAC with a hard or soft reset to restart the DMA to recover from this condition.

The EMAC supports up to 16 outstanding transactions on the interface. Buffering outstanding transactions smooths out back pressure behavior. This is important when resource contention bottlenecks arise under high system load conditions.

Cache Control Interface

The system manager provides the values for the master cache outputs through this interface. These inputs are used as the outputs to the L3 interconnect extending the capabilities of this block with respect to the cacheable characteristics of master transfers.

To configure EMAC DMA controller to perform cacheable accesses, configure the cache bits in the system manager. Cache bits should only be accessed at boot time, before the EMAC controller is brought out of reset.



For more information, refer to the *System Manager* chapter in volume 3 of the *Cyclone V Device Handbook*.

External PHY

The following PHY interfaces are supported for the HPS:

- RGMII for 10/100/1000

The EMAC also has a control interface used for configuration and status monitoring of the PHY. In this case, the PHY is the slave device. There are two choices of control interface:

- MDIO
- I²C interface

The MDIO interface is built into the EMAC while the I²C interface uses separate I²C peripherals residing on the HPS. The interfaces are multiplexed externally to the EMAC.

Transmit and Receive Data FIFO Buffers

Each EMAC component has associated transmit and receive data FIFO buffer instances. Both FIFO buffer instances are 1024 x 42 bits. The FIFO buffer word consists of:

- Data: 32 bits
- Sideband:
 - End of frame (EOF): one bit
 - Byte enables (BE): two bits
 - Error correction code (ECC): seven bits

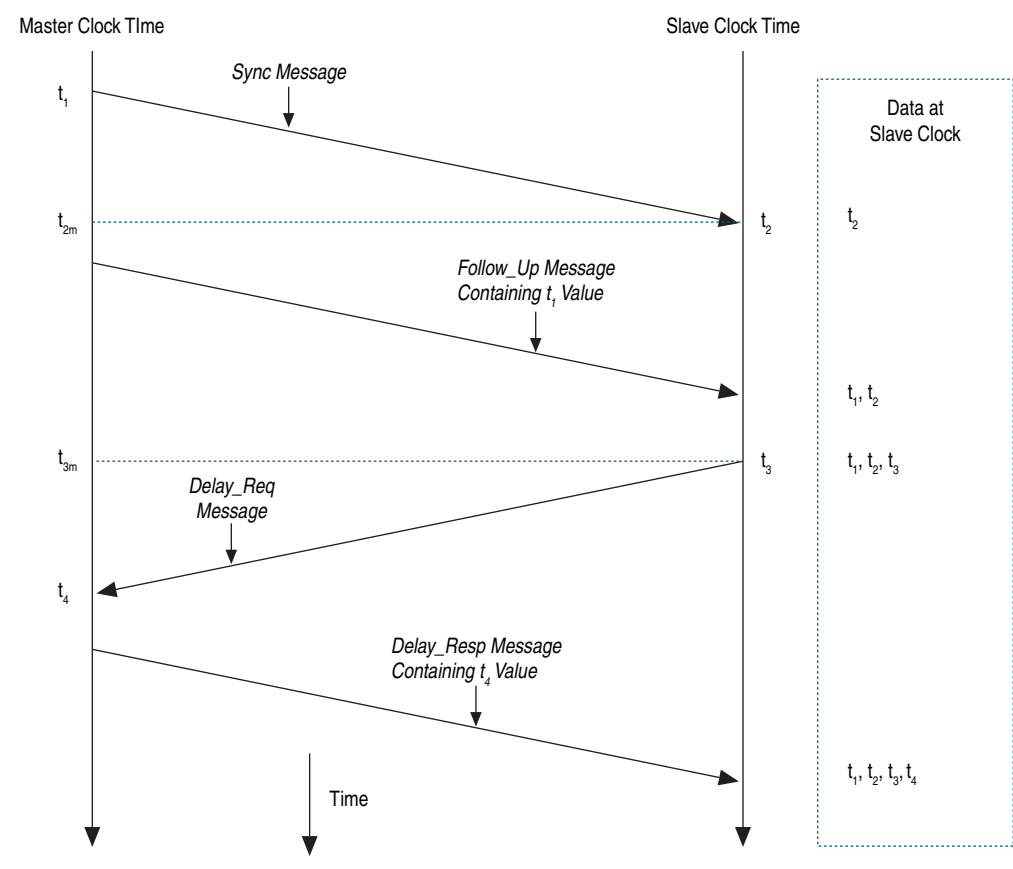
The data and sideband are protected by the seven-bit single error correct, double error detect (SEC-DED) code word. These FIFO buffer RAMs also contain ECC enable, error injection and status pins. The enable and error injection pins are inputs driven by the system manager and the status pins are outputs driven to the MPU subsystem.

IEEE 1588-2002 Time Stamps

The IEEE 1588-2002 standard defines the Precision Time Protocol (PTP) which enables precise synchronization of clocks in a distributed network of devices. The PTP applies to systems communicating by local area networks supporting multicast messaging. This protocol enables heterogeneous systems that include clocks of varying inherent precision, resolution, and stability to synchronize. It is frequently used in automation systems where a collection of communicating machines such as robots must be synchronized and hence operate over a common time base. †

The PTP is transported over UDP/IP. The system or network is classified into Master and Slave nodes for distributing the timing and clock information. Figure 17-3 shows the process that PTP uses for synchronizing a slave node to a master node by exchanging PTP messages. †

Figure 17-3. Networked Time Synchronization



As shown in Figure 17-3, the PTP uses the following process: †

1. The master broadcasts the PTP Sync messages to all its nodes. The Sync message contains the master's reference time information. The time at which this message leaves the master's system is t_1 . This time must be captured, for Ethernet ports, at the PHY interface. †
2. The slave receives the Sync message and also captures the exact time, t_2 , using its timing reference. †
3. The master sends a Follow_up message to the slave, which contains t_1 information for later use. †
4. The slave sends a Delay_Req message to the master, noting the exact time, t_3 , at which this frame leaves the PHY interface. †
5. The master receives the message, capturing the exact time, t_4 , at which it enters its system. †
6. The master sends the t_4 information to the slave in the Delay_Resp message. †

7. The slave uses the four values of t1, t2, t3, and t4 to synchronize its local timing reference to the master's timing reference. †

Most of the PTP implementation is done in the software above the UDP layer. However, the hardware support is required to capture the exact time when specific PTP packets enter or leave the Ethernet port at the PHY interface. This timing information must be captured and returned to the software for the proper implementation of PTP with high accuracy. †

The EMAC is intended to support IEEE 1588 operation in all modes with a resolution of one μ s. When the two EMACs are operating in an IEEE 1588 environment, the MPU subsystem is responsible for maintaining synchronization between the time counters internal to the two MACs. †

The IEEE 1588 interface to the FPGA allows the FPGA to provide an alternate source for the `emac_ptp_ref_clk` input as well to allow it to monitor the pulse per second output from each EMAC controller. †

The EMAC component provides a hardware assisted implementation of the IEEE 1588 protocol. Hardware support is for timestamp maintenance. Timestamps are updated when receiving any frame on the PHY interface and the receive descriptor is updated with this value. Timestamps are also updated when the SFD of a frame is transmitted and updates the transmit descriptor accordingly. †



For details about the IEEE 1588-2002 standard, refer to *IEEE Standard 1588-2002 - IEEE Standard for a Precision Clock Synchronization Protocol for Networked Measurement and Control Systems*, available on the IEEE Standards Association website (standards.ieee.org). †

Reference Timing Source

To get a snapshot of the time, the EMAC takes the reference clock input and uses it to generate the reference time (64-bit) internally and capture timestamps. †

System Time Register Module

The 64-bit time is maintained in this module and updated using the input reference clock, `osc1_clk`. The `osc1_clk` clock comes from the clock manager and the `emac_ptp_ref_clk` clock comes from the FPGA fabric. This time is the source for taking snapshots (timestamps) of Ethernet frames being transmitted or received at the PHY interface.

The system time counter can be initialized or corrected using the coarse correction method. In this method, the initial value or the offset value is written to the Timestamp Update register. For initialization, each EMAC's system time counter is written with the value in the Timestamp Update registers, while for system time correction, the offset value is added to or subtracted from the system time.

In the fine correction method, a slave clock's frequency drift with respect to the master clock is corrected over a period of time instead of in one clock, as in coarse correction. This helps maintain linear time and does not introduce drastic changes (or a large jitter) in the reference time between PTP sync message intervals. †

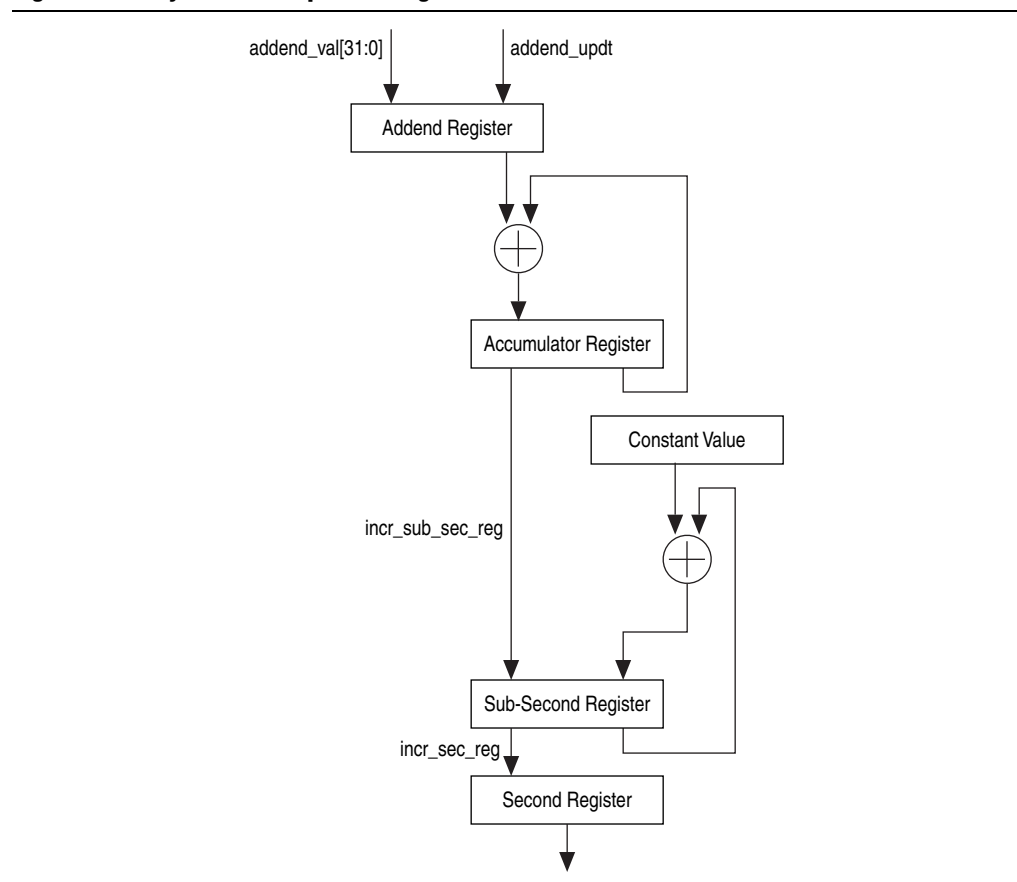
In this method, an accumulator sums up the contents of the `Timestamp_Addend` register, as shown in Figure 17-4. The arithmetic carry that the accumulator generates is used as a pulse to increment the system time counter. The accumulator and the addend are 32-bit registers. Here, the accumulator acts as a high-precision frequency multiplier or divider.



You must connect a PTP clock with a frequency higher than the frequency required for the specified accuracy. †

This algorithm is depicted in Figure 17-4: †

Figure 17-4. System Time Update Using Fine Method



The System Time Update logic requires a 50-MHz clock frequency to achieve 20-ns accuracy. The frequency division ratio (`FreqDivisionRatio`) is the ratio of the reference clock frequency to the required clock frequency. Hence, if the reference clock (`clk_ptp_ref_i`) is, for example, 66 MHz, this ratio is calculated as $66 \text{ MHz} / 50 \text{ MHz} = 1.32$. Hence, the default addend value to be set in the register is $232 / 1.32$, `0xC1F07C1F`.

If the reference clock drifts lower, to 65 MHz for example, the ratio is $65 / 50$, or 1.3 and the value to set in the addend register is $232 / 1.30$, or `0xC4EC4EC4`. If the clock drifts higher, to 67 MHz for example, the addend register must be set to `0xBF0B7672`. When the clock drift is nil, the default addend value of `0xC1F07C1F` ($232 / 1.32$) must be programmed. †

In Figure 17-4, the constant value used to accumulate the sub-second register is decimal 43, which achieves an accuracy of 20 ns in the system time (in other words, it is incremented in 20-ns steps).

The software must calculate the drift in frequency based on the Sync messages and update the Addend register accordingly. †

Initially, the slave clock is set with FreqCompensationValue₀ in the Addend register. This value is as follows: †

$$\text{FreqCompensationValue}_0 = 232 / \text{FreqDivisionRatio} \dagger$$

If MasterToSlaveDelay is initially assumed to be the same for consecutive Sync messages, the algorithm described below must be applied. After a few Sync cycles, frequency lock occurs. The slave clock can then determine a precise MasterToSlaveDelay value and re-synchronize with the master using the new value. †

The algorithm is as follows: †

- At time MasterSyncTime_n the master sends the slave clock a Sync message. The slave receives this message when its local clock is SlaveClockTime_n and computes MasterClockTime_n as: †

$$\text{MasterClockTime}_n = \text{MasterSyncTime}_n + \text{MasterToSlaveDelay}_n \dagger$$

- The master clock count for current Sync cycle, MasterClockCount_n is given by: †

$$\text{MasterClockCount}_n = \text{MasterClockTime}_n - \text{MasterClockTime}_{n-1} \dagger$$

(assuming that MasterToSlaveDelay is the same for Sync cycles n and n – 1) †

- The slave clock count for current Sync cycle, SlaveClockCount_n is given by: †

$$\text{SlaveClockCount}_n = \text{SlaveClockTime}_n - \text{SlaveClockTime}_{n-1} \dagger$$

- The difference between master and slave clock counts for current Sync cycle, ClockDiffCount_n is given by: †

$$\text{ClockDiffCount}_n = \text{MasterClockCount}_n - \text{SlaveClockCount}_n \dagger$$

- The frequency-scaling factor for slave clock, FreqScaleFactor_n is given by: †

$$\text{FreqScaleFactor}_n = (\text{MasterClockCount}_n + \text{ClockDiffCount}_n) / \text{SlaveClockCount}_n \dagger$$

- The frequency compensation value for Addend register, FreqCompensationValue_n is given by: †

$$\text{FreqCompensationValue}_n = \text{FreqScaleFactor}_n \times \text{FreqCompensationValue}_{n-1} \dagger$$

In theory, this algorithm achieves lock in one Sync cycle; however, it may take several cycles, because of changing network propagation delays and operating conditions. †

This algorithm is self-correcting: if for any reason the slave clock is initially set to a value from the master that is incorrect, the algorithm corrects it at the cost of more Sync cycles. †

Transmit Path Functions

The MAC captures a timestamp when the SFD of a frame is sent on the PHY interface. The frames for which you want to capture timestamps are controllable on a per-frame basis. In other words, each transmit frame can be marked to indicate whether a timestamp should be captured for that frame. The MAC does not process the transmitted frames to identify the PTP frames. You need to specify the frames for which you want to capture timestamps. The MAC returns the timestamp, along with the Transmit status of the frame, to hardware implemented in the FPGA. You can use the control bits in the transmit descriptor. The MAC returns the timestamp to the software inside the corresponding transmit descriptor, thus connecting the timestamp automatically to the specific PTP frame. †

Receive Path Functions

The MAC captures the timestamp of all frames received on the PHY interface. The DMA returns the timestamp to the software in the corresponding receive descriptor. The timestamp is written only to the last receive descriptor. †

Timestamp Error Margin

According to the IEEE 1588 specifications, a timestamp must be captured at the SFD of the transmitted and received frames at the PHY interface. Because the PHY interface receive and transmit clocks are not synchronous to the reference timestamp clock (`osc1_clk`) a small amount of drift is introduced when a timestamp is moved between asynchronous clock domains. In the transmit path, the captured and reported timestamp has a maximum error margin of two PTP clocks. It means that the captured timestamp has the reference timing source value that is given within two clocks after the SFD is transmitted on the PHY interface. †

Similarly, in the receive path, the error margin is three PHY interface clocks, plus up to two PTP clocks. You can ignore the error margin because of the PHY interface clocks by assuming that this constant delay is present in the system (or link) before the SFD data reaches the PHY interface of the MAC. †

Frequency Range of Reference Timing Clock

The timestamp information is transferred across asynchronous clock domains, that is, from MAC clock domain to the FPGA clock domain. Therefore, a minimum delay is required between two consecutive timestamp captures. This delay is four clock cycles of the PHY interface and three clock cycles of PTP clocks. If the delay between two timestamp captures is less than this delay, the MAC does not take a timestamp snapshot for the second frame. †

The maximum PTP clock frequency is limited by the maximum resolution of the reference time (20 ns resulting in 50 MHz) and the timing constraints achievable for logic operating on the PTP clock. In addition, the resolution, or granularity, of the reference time source determines the accuracy of the synchronization. Therefore, a higher PTP clock frequency gives better system performance. †

The minimum PTP clock frequency depends on the time required between two consecutive SFD bytes. Because the PHY interface clock frequency is fixed by the IEEE 1588 specification, the minimum PTP clock frequency required for proper operation depends upon the operating mode and operating speed of the MAC as shown in Table 17-3. †

Table 17-3. Minimum PTP Clock Frequency Example

Mode	Minimum Gap Between Two SFDs	Minimum PTP Frequency
100-Mbps full-duplex operation	168 MII clocks (128 clocks for a 64-byte frame + 24 clocks of min IFG + 16 clocks of preamble)	$(3 * \text{PTP}) + (4 * \text{MII}) \leq 168 * \text{MII}$, that is, ~0.5 MHz $((168 - 4) * 40 \text{ ns} \div 3 = 2180 \text{ ns period})$
1000-Mbps half-duplex operation	24 GMII clocks (4 for a jam pattern sent just after SFD because of collision + 12 IFG + 8 preamble) ⁽¹⁾	$3 * \text{PTP} + 4 * \text{GMII} \leq 24 * \text{GMII}$, that is, 18.75 MHz
Notes to Table 17-3: (1) For details about jam patterns, refer to <i>IEEE Std 802.3-2008 Part 3: Carrier sense multiple access with Collision Detection (CSMA/CD) Access Method and Physical Layer Specifications</i> , available on the IEEE website (standards.ieee.org/findstds/).		

IEEE 1588-2008 Advanced Timestamps

In addition to the basic timestamp features mentioned in IEEE 1588-2002 Timestamps, the EMAC supports the following advanced timestamp features defined in the IEEE 1588-2008 standard. †

- Supports the IEEE 1588-2008 (version 2) timestamp format. †
- Provides an option to take a timestamp of all frames or only PTP type frames. †
- Provides an option to take a timestamp of only event messages. †
- Provides an option to take the timestamp based on the clock type: ordinary, boundary, end-to-end, or peer-to-peer. †
- Provides an option to configure the EMAC to be a master or slave for ordinary and boundary clock. †
- Identifies the PTP message type, version, and PTP payload in frames sent directly over Ethernet and sends the status. †
- Provides an option to measure sub-second time in digital or binary format. †



For details about the IEEE 1588-2008 standard, refer to *IEEE Standard 1588-2008 - IEEE Standard for a Precision Clock Synchronization Protocol for Networked Measurement and Control Systems*, available on the IEEE Standards Association website (standards.ieee.org). †

Peer-to-Peer PTP Transparent Clock (P2P TC) Message Support

The IEEE 1588-2008 version supports Peer-to-Peer PTP (Pdelay) messages in addition to SYNC, Delay Request, Follow-up, and Delay Response messages. †

Clock Types

The EMAC supports the following clock types defined in the IEEE 1588-2008 standard: †

- Ordinary clock †
- Boundary clock †
- End-to-End transparent clock †
- Peer-to-Peer transparent clock †

Reference Timing Source

The EMAC supports the following reference timing source features defined in the IEEE 1588-2008 standard: †

- 48-Bit seconds Field †
- Fixed pulse-per-second output †
- Flexible pulse-per-second output †
- Auxiliary snapshots (timestamps) with external events

Transmit Path Functions

The advanced timestamp feature is supported only through the alternate (enhanced) descriptors format. †

Receive Path Functions

The MAC processes the received frames to identify valid PTP frames. You can control the snapshot of the time, to be sent to the application, by using the following options: †

- Enable timestamp for all frames. †
- Enable timestamp for IEEE 1588 version 2 or version 1 timestamp. †
- Enable timestamp for PTP frames transmitted directly over Ethernet or UDP/IP Ethernet. †
- Enable timestamp snapshot for the received frame for IPv4 or IPv6. †
- Enable timestamp snapshot for EVENT messages (SYNC, DELAY_REQ, PDELAY_REQ, or PDELAY_RESP) only. †
- Enable the node to be a master or slave and select the timestamp type. This controls the type of messages for which timestamps are taken. †

The DMA returns the timestamp to the software inside the corresponding transmit or receive descriptor. The advanced timestamp feature is supported only with the 32-byte alternate (enhanced) descriptor. †

Auxiliary Snapshot

The auxiliary snapshot feature allows you to store a snapshot (timestamp) of the system time based on an external event. The event is considered to be the rising edge of the sideband signal `ptp_aux_ts_trig_i`. One Auxiliary snapshot input is available. The depth of the Auxiliary snapshot FIFO buffer is 16. †

The timestamps taken for any input are stored in a common FIFO buffer. The host can read a register to know which input's timestamp is available for reading at the top of this FIFO buffer. The MAC stores these timestamps in a FIFO buffer. Only 64 bits of the timestamp are stored in the FIFO buffer. When a timestamp is stored, the MAC indicates this to the host with an interrupt. The value of the timestamp is read through a FIFO buffer register access. †

IEEE 802.3az Energy Efficient Ethernet

Energy Efficient Ethernet (EEE) standardized by IEEE 802.3-az, version D2.0 is supported by the EMAC. It is supported by the MAC operating in 10/100/1000 Mbps rates. EEE is only supported when the EMAC is configured to operate with the RGMII PHY interface operating in full-duplex mode. It does not support half-duplex mode. †



For details about the IEEE 802.3az Energy Efficient Ethernet standard, refer to the IEEE 802.3 Ethernet Working Group website (www.ieee802.org/3/). †

EEE enables the MAC to operate in Low-Power Idle (LPI) mode. Either end point of an Ethernet link can disable functionality to save power during periods of low link utilization. The MAC controls whether the system should enter or exit LPI mode and communicates this to the PHY. †

LPI Timers

Two timers internal to the EMAC are associated with LPI mode: †

- LPI Link Status (LS) Timer †
- LPI TW Timer †

The LPI LS timer counts, in ms, the time expired since the link status is up. This timer is cleared every time the link goes down and is incremented when the link is up again and the terminal count as programmed by the software is reached. The PHY interface does not assert the LPI pattern unless the terminal count is reached. This ensures a minimum time for which no LPI pattern is asserted after a link is established with the remote station. This period is defined as one second in the IEEE standard 802.3-az, version D2.0. The LPI LS timer is 10 bits wide. Therefore, the software can program up to 1023 ms. †

The LPI TW timer counts, in μ s, the time expired since the deassertion of LPI. The terminal count of the timer is the value of resolved transmit TW that is the auto-negotiated time after which the MAC can resume the normal transmit operation. The MAC supports the LPI TW timer in units of μ s. The LPI TW timer is 16 bits wide. Therefore, the software can program up to 65535 μ s. †

The EMAC generates the LPI interrupt when the transmit or receive channel enters or exits the LPI state. †

Checksum Offload

Communication protocols such as TCP and UDP implement checksum fields, which help determine the integrity of data transmitted over a network. Because the most widespread use of Ethernet is to encapsulate TCP and UDP over IP datagrams, the EMAC has a Checksum Offload Engine (COE) to support checksum calculation and insertion in the transmit path, and error detection in the receive path. Supported offloading types are shown below: †

- Transmit IP header checksum †
- Transmit TCP/UDP/ICMP checksum †
- Receive IP header checksum †
- Receive full checksum †

Frame Filtering

The EMAC implements the following types of filtering for receive frames. †

Source Address or Destination Address Filtering

The Address Filtering Module checks the destination and source address field of each incoming packet. †

- “Unicast Destination Address Filter”
- “Multicast Destination Address Filter”
- “Hash or Perfect Address Filter”
- “Broadcast Address Filter”
- “Unicast Source Address Filter”
- “Inverse Filtering Operation (Invert the filter-match result at final output)”

Unicast Destination Address Filter

Up to 128 MAC addresses for unicast perfect filtering are supported. The filter compares all 48 bits of the received unicast address with the programmed MAC address for any match. Default MacAddr0 is always enabled, other addresses MacAddr1–MacAddr127 are selected with an individual enable bit. For MacAddr1–MacAddr31 addresses, you can mask each byte during comparison with the corresponding received DA byte. This enables group address filtering for the DA. The MacAddr32–MacAddr127 addresses do not have mask control and all six bytes of the MAC address are compared with the received six bytes of DA. †

In hash filtering mode, the filter performs imperfect filtering for unicast addresses using a 64-bit hash table. It uses the upper six bits of the CRC of the received destination address to index the content of the hash table. A value of 0 selects Bit 0 of the selected register, and a value of 111111 binary selects Bit 63 of the Hash Table register. If the corresponding bit is set to one, the unicast frame is said to have passed the hash filter; otherwise, the frame has failed the hash filter. †

Multicast Destination Address Filter

The MAC can be programmed to pass all multicast frames. In Perfect Filtering mode, the multicast address is compared with the programmed MAC Destination Address registers (1–31). Group address filtering is also supported. In hash filtering mode, the filter performs imperfect filtering using a 64-bit hash table. For hash filtering, it uses the upper six bits of the CRC of the received multicast address to index the contents of the hash table. A value of 0 selects Bit 0 of the selected register and a value of 111111 binary selects Bit 63 of the Hash Table register. If the corresponding bit is set to one, then the multicast frame is said to have passed the hash filter; otherwise, the frame has failed the hash filter. †

Hash or Perfect Address Filter

The filter can be configured to pass a frame when its DA matches either the hash filter or the Perfect filter. This configuration applies to both unicast and multicast frames. †

Broadcast Address Filter

The filter does not filter any broadcast frames in the default mode. However, if the MAC is programmed to reject all broadcast frames, the filter drops any broadcast frame. †

Unicast Source Address Filter

The MAC can also perform a perfect filtering based on the source address field of the received frames. Group filtering with SA is also supported. You can filter a group of addresses by masking one or more bytes of the address. †

Inverse Filtering Operation (Invert the filter-match result at final output)

For both Destination and Source address filtering, there is an option to invert the filter-match result at the final output. The result of the unicast or multicast destination address filter is inverted in this mode. †

VLAN Filtering

The EMAC supports the two kinds of VLAN filtering: †

- VLAN tag-based filtering †
- VLAN hash filtering †

VLAN tag-based filtering

In the VLAN tag-based frame filtering, the MAC compares the VLAN tag of the received frame and provides the VLAN frame status to the application. Based on the programmed mode, the MAC compares the lower 12 bits or all 16 bits of the received VLAN tag to determine the perfect match. If VLAN tag filtering is enabled, the MAC forwards the VLAN-tagged frames along with VLAN tag match status and drops the VLAN frames that do not match. You can also enable the inverse matching for VLAN frames. In addition, you can enable matching of SVLAN tagged frames along with the default Customer Virtual Local Area Network (C-VLAN) tagged frames. †

VLAN hash filtering with a 16-bit hash table

The MAC provides VLAN hash filtering with a 16-bit hash table. The MAC also supports the inverse matching of the VLAN frames. In inverse matching mode, when the VLAN tag of a frame matches the perfect or hash filter, the packet should be dropped. If the VLAN perfect and VLAN hash match are enabled, a frame is considered as matched if either the VLAN hash or the VLAN perfect filter matches. When inverse match is set, a packet is forwarded only when both perfect and hash filters indicate mismatch. †

Layer 3 and Layer 4 Filters

Layer 3 filtering refers to source address and destination address filtering. Layer 4 filtering refers to source port and destination port filtering. The frames are filtered in the following ways: †

- Matched frames †
- Unmatched frames †
- Non-TCP or UDP IP frames †

Matched Frames

The MAC forwards the frames, which match all enabled fields, to the application along with the status. The MAC gives the matched field status only if one of the following conditions is true: †

- All enabled Layer 3 and Layer 4 fields match. †
- At least one of the enabled field matches and other fields are bypassed or disabled. †

Using the CSR set, you can define up to four filters, identified as filter 0 through filter 3. When multiple Layer 3 and Layer 4 filters are enabled, any filter match is considered as a match. If more than one filter matches, the MAC provides status of the lowest filter with filter 0 being the lowest and filter 3 being the highest. For example, if filter 0 and filter 1 match, the MAC gives the status corresponding to filter 0. †

Unmatched Frames

The MAC drops the frames that do not match any of the enabled fields. You can use the inverse match feature to block or drop a frame with specific TCP or UDP over IP fields and forward all other frames. You can configure the EMAC so that when a frame is dropped, it receives a partial frame with appropriate abort status or drops it completely. †

Non-TCP or UDP IP Frames

By default, all non-TCP or UDP IP frames are bypassed from the Layer 3 and Layer 4 filters. You can optionally program the MAC to drop all non-TCP or UDP over IP frames. †

Clocks and Resets

The Ethernet MAC controller uses the clocks shown in [Table 17-4](#).

Table 17-4. Clocks

Name	Nominal Frequency	Functional Usage	Notes
clk_ref_i	250 Mhz	Reference Clock to the EMAC	If supplied from clock interface, clock is emac0_clk or emac1_clk
clk_tx_i	125/25/2.5 Mhz	Autonegotiates speed down to 10/100Mbps	
clk_rx_i		PHY provides this reference to MAC	All PHY signals received by the MAC are synchronous to this clock

Clock Gating for EEE

For the RGMII PHY interface, you can gate the transmit clock for Energy Efficient Ethernet (EEE) applications. For more information, refer to [“Programming Guidelines for Energy Efficient Ethernet”](#) on page 17-63.

Resets

The Ethernet MAC controller uses the reset signals shown in [Table 17-5](#).

Table 17-5. Resets

Name	Nominal Frequency	Functional Usage	Notes
rst_clk_tx_n_o		Transmit clock reset output	Used to reset external PHY transmit clock domain logic
rst_clk_rx_n_o		Receive clock reset output	Used to reset external PHY receive clock domain logic

Interrupts

Interrupts are generated as a result of specific events in the EMAC and external PHY device. The interrupt status register indicates all conditions which may trigger an interrupt and the interrupt enable register determines which interrupts can propagate.

Ethernet MAC Programming Model

DMA Controller

The DMA has independent transmit and receive engines, and a CSR space. The transmit engine transfers data from system memory to the device port or MAC transaction layer (MTL), while the receive engine transfers data from the device port to the system memory. The controller use descriptors to efficiently move data from source to destination with minimal Host CPU intervention. The DMA is designed for packet-oriented data transfers such as frames in Ethernet. The controller can be programmed to interrupt the Host CPU for situations such as frame transmit and receive transfer completion, and other normal/error conditions.

The DMA and the Host driver communicate through two data structures: †

- Control and Status registers (CSR) †
- Descriptor lists and data buffers †

For information about Control and Status registers, refer to “Ethernet MAC Address Map and Register Definitions” on page 17-67. Descriptors are described in “Normal Descriptor” on page 17-36 and “Alternate or Enhanced Descriptors” on page 17-47.



You can select an alternative descriptor structure during RTL configuration. The control bits in this descriptor structure are reassigned so that the application can use a larger buffer size (8 KB). For a detailed bit map of this alternative descriptor structure, refer to “Alternate or Enhanced Descriptors” on page 17-47. All descriptions in “DMA Controller” on page 17-21 refer to the default descriptor structure, not this new alternative. If you are using the alternate descriptor structure, ignore the descriptor-specific mapping in “DMA Controller” on page 17-21 and refer to the alternate descriptor-specific bit maps.

The DMA transfers data frames received by the MAC to the receive Buffer in the Host memory, and transmit data frames from the transmit Buffer in the Host memory. Descriptors that reside in the Host memory act as pointers to these buffers. †

There are two descriptor lists; one for reception, and one for transmission. The base address of each list is written into Register 3 (Receive Descriptor List Address Register) and Register 4 (Transmit Descriptor List Address Register), respectively. A descriptor list is forward linked (either implicitly or explicitly). The last descriptor may point back to the first entry to create a ring structure. Explicit chaining of descriptors is accomplished by setting the second address chained in both receive and transmit descriptors (RDES1[24] and TDES1[24]). The descriptor lists resides in the Host physical memory address space. Each descriptor can point to a maximum of two buffers. This enables two buffers to be used, physically addressed, rather than contiguous buffers in memory. †

A data buffer resides in the Host physical memory space, and consists of an entire frame or part of a frame, but cannot exceed a single frame. Buffers contain only data, buffer status is maintained in the descriptor. Data chaining refers to frames that span multiple data buffers. However, a single descriptor cannot span multiple frames. The DMA skips to the next frame buffer when end-of-frame is detected. Data chaining can be enabled or disabled. †

The descriptor ring and chain structures are shown in Figure 17-5 and Figure 17-6. †

Figure 17-5. Descriptor Ring Structure

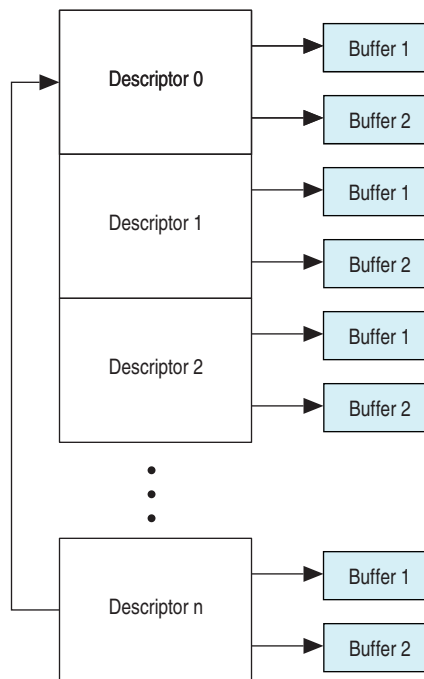
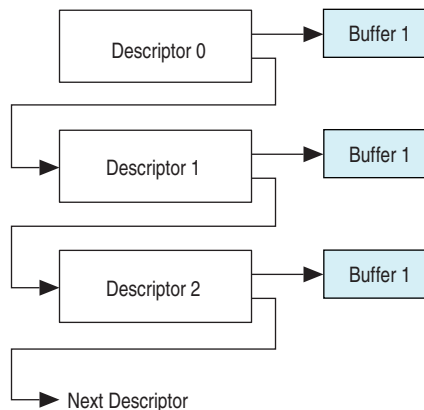


Figure 17-6. Descriptor Chain Structure



Initialization

Initialization for the EMAC is as follows.

1. Write to Register 0 (Bus Mode Register) to set Host bus access parameters. †
2. Write to Register 7 (Interrupt Enable Register) to mask unnecessary interrupt causes. †
3. Create the transmit and receive descriptor lists, and then write to DMA Register 3 (Receive Descriptor List Address Register) and Register 4 (Transmit Descriptor List Address Register), providing the DMA with the starting address of each list. †

4. Write to Register 1 (MAC Frame Filter), Register 2 (Hash Table High Register), and Register 3 (Hash Table Low Register) for desired filtering options. †
5. Write to Register 1 (MAC Frame Filter) to configure the operating mode and enable the transmit operation (Bit 3: Transmitter Enable). The PS and DM bits are set based on the auto-negotiation result (read from the PHY). †
6. Write to Register 6 (Operation Mode Register) to set Bits 13 and 1 to start transmission and reception. †
7. Write to Register 0 (MAC Configuration Register) to enable the receive operation (Bit 2: Receiver Enable). †

The transmit and receive engines enter the Running state and attempt to acquire descriptors from the respective descriptor lists. The receive and transmit engines then begin processing receive and transmit operations. The transmit and receive processes are independent of each other and can be started or stopped separately. †

Host Bus Burst Access

The DMA attempts to execute fixed-length Burst transfers on the master interface if configured to do so through FB bit of Register 0 (Bus Mode Register). The maximum Burst length is indicated and limited by the PBL field (Bits [13:8]) Register 0 (Bus Mode Register). The receive and transmit descriptors are always accessed in the maximum possible (limited by PBL or $16 * 8 / \text{bus width}$) burst-size for the 16- bytes to be read.

The transmit DMA initiates a data transfer only when sufficient space to accommodate the configured burst is available in MTL transmit FIFO buffer or the number of bytes till the end of frame (when it is less than the configured burst-length). The DMA indicates the start address and the number of transfers required to the master interface. When the interface is configured for fixed-length burst, then it transfers data using the best combination of INCR4, 8, or 16 and SINGLE transactions. Otherwise (no fixed-length burst), it transfers data using INCR (undefined length) and SINGLE transactions.

The receive DMA initiates a data transfer only when sufficient data to accommodate the configured burst is available in MTL receive FIFO buffer or when the end of frame (when it is less than the configured burst-length) is detected in the receive FIFO buffer. The DMA indicates the start address and the number of transfers required to the master interface. When the interface is configured for fixed-length burst, then it transfers data using the best combination of INCR4, 8, or 16 and SINGLE transactions. If the end-of frame is reached before the fixed-burst ends on the interface, then dummy transfers are performed in order to complete the fixed-burst. Otherwise (FB bit of Register 0 (Bus Mode Register) is reset), it transfers data using INCR (undefined length) and SINGLE transactions.

When the interface is configured for address-aligned beats, both DMA engines ensure that the first burst transfer initiated is less than or equal to the size of the configured PBL. Thus, all subsequent beats start at an address that is aligned to the configured PBL. The DMA can only align the address for beats up to size 16 (for $\text{PBL} > 16$), because the interface does not support more than INCR16.

Host Data Buffer Alignment

The transmit and receive data buffers do not have any restrictions on start address alignment. For example, in systems with 32-bit memory, the start address for the buffers can be aligned to any of the four bytes. However, the DMA always initiates transfers with address aligned to the bus width with dummy data for the byte lanes not required. This typically happens during the transfer of the beginning or end of an Ethernet frame. The software driver should discard the dummy bytes based on the start address of the buffer and size of the frame. †

Example: Buffer Read

If the transmit buffer address is 0x0000FF2 (for 32-bit data bus), and 15 bytes need to be transferred, then the DMA reads five full words from address 0x0000FF0, but when transferring data to the MTL transmit FIFO buffer, the extra bytes (the first two bytes) are dropped or ignored. Similarly, the last 3 bytes of the last transfer are also ignored. The DMA always ensures it transfers a full 32-bit data to the MTL transmit FIFO buffer, unless it is the end-of-frame.

Example: Buffer Write

If the receive buffer address is 0x0000FF2 (for 64-bit data bus) and 16 bytes of a received frame need to be transferred, then the DMA writes 3 full words from address 0x0000FF0. But the first 2 bytes of first transfer and the last 6 bytes of the third transfer have dummy data.

Buffer Size Calculations

The DMA does not update the size fields in the transmit and receive descriptors. The DMA updates only the status fields (RDES and TDES) of the descriptors. The driver has to perform the size calculations. †

The transmit DMA transfers the exact number of bytes (indicated by buffer size field of TDES1) towards the MAC. If a descriptor is marked as first (FS bit of TDES1 is set), then the DMA marks the first transfer from the buffer as the start of frame. If a descriptor is marked as last (LS bit of TDES1), then the DMA marks the last transfer from that data buffer as the end-of frame to the MTL. †

The receive DMA transfers data to a buffer until the buffer is full or the end-of frame is received from the MTL. If a descriptor is not marked as last (LS bit of RDES0), then the descriptor's corresponding buffer(s) are full and the amount of valid data in a buffer is accurately indicated by its buffer size field minus the data buffer pointer offset when the FS bit of that descriptor is set. The offset is zero when the data buffer pointer is aligned to the data bus width. If a descriptor is marked as last, then the buffer may not be full (as indicated by the buffer size in RDES1). To compute the amount of valid data in this final buffer, the driver must read the frame length (FL bits of RDES0[29:16]) and subtract the sum of the buffer sizes of the preceding buffers in this frame. The receive DMA always transfers the start of next frame with a new descriptor. †



Even when the start address of a receive buffer is not aligned to the data width of system bus, the system should allocate a receive buffer of a size aligned to the system bus width. For example, if the system allocates a 1,024-byte (1 KB) receive buffer starting from address 0x1000, the software can program the buffer start address in the receive descriptor to have a 0x1002 offset. The receive DMA writes the frame to this buffer with dummy data in the first two locations (0x1000 and 0x1001). The actual frame is written from location 0x1002. Thus, the actual useful space in this buffer is 1,022 bytes, even though the buffer size is programmed as 1,024 bytes, because of the start address offset. †

Transmission

Transmission functions use transmit descriptors, described in detail in “[Transmit Descriptor](#)” on page 17-36.

TX DMA Operation: Default (Non-OSF) Mode

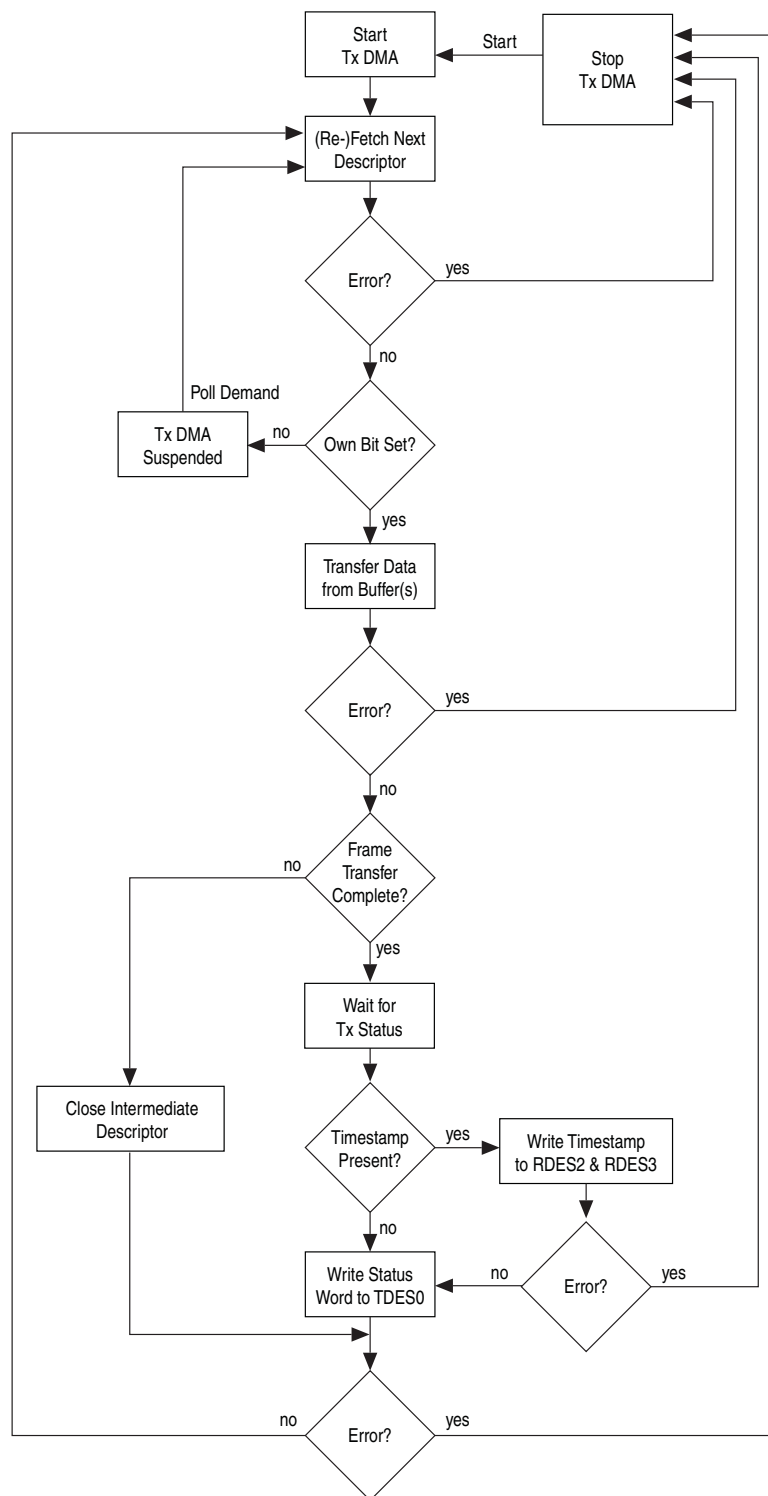
The transmit DMA engine in default mode proceeds as follows: †

1. The Host sets up the transmit descriptor (TDES0-TDES3) and sets the Own bit (TDES0[31]) after setting up the corresponding data buffer(s) with Ethernet frame data. †
2. When Bit 13 (ST) of Register 6 (Operation Mode Register) is set, the DMA enters the Run state. †
3. While in the Run state, the DMA polls the transmit descriptor list for frames requiring transmission. After polling starts, it continues in either sequential descriptor ring order or chained order. If the DMA detects a descriptor flagged as owned by the Host (TDES0[31] = 0), or if an error condition occurs, transmission is suspended and both the Bit 2 (Transmit Buffer Unavailable) and Bit 16 (Normal Interrupt Summary) of the Register 5 (Status Register) are set. The transmit Engine proceeds to Step 9.
4. If the acquired descriptor is flagged as owned by DMA (TDES0[31] = 1), the DMA decodes the transmit Data Buffer address from the acquired descriptor.
5. The DMA fetches the transmit data from the Host memory and transfers the data to the MTL for transmission. †
6. If an Ethernet frame is stored over data buffers in multiple descriptors, the DMA closes the intermediate descriptor and fetches the next descriptor. Steps 3, 4, and 5 are repeated until the end-of-Ethernet-frame data is transferred to the MTL. †
7. When frame transmission is complete, if IEEE 1588 timestamping was enabled for the frame (as indicated in the transmit status) the timestamp value obtained from MTL is written to the transmit descriptor (TDES2 and TDES3) that contains the end-of-frame buffer. The status information is then written to this transmit descriptor (TDES0). Because the Own bit is cleared during this step, the Host now owns this descriptor. If timestamping was not enabled for this frame, the DMA does not alter the contents of TDES2 and TDES3. †

8. Bit 0 (Transmit Interrupt) of Register 5 (Status Register) is set after completing transmission of a frame that has Interrupt on Completion (TDES1[31]) set in its Last descriptor. The DMA engine then returns to Step 3. †
9. In the Suspend state, the DMA tries to re-acquire the descriptor (and thereby return to Step 3) when it receives a Transmit Poll demand and the Underflow Interrupt Status bit is cleared. †

The TX DMA transmission flow in default mode is shown in Figure 17-7. †

Figure 17-7. TX DMA Operation in Default Mode



TX DMA Operation: OSF Mode

While in the Run state, the transmit process can simultaneously acquire two frames without closing the Status descriptor of the first [if Bit 2 (OSF) in Register 6 (Operation Mode Register) is set]. As the transmit process finishes transferring the first frame, it immediately polls the transmit descriptor list for the second frame. If the second frame is valid, the transmit process transfers this frame before writing the first frame's status information. †

In OSF mode, the Run state transmit DMA operates in the following sequence: †

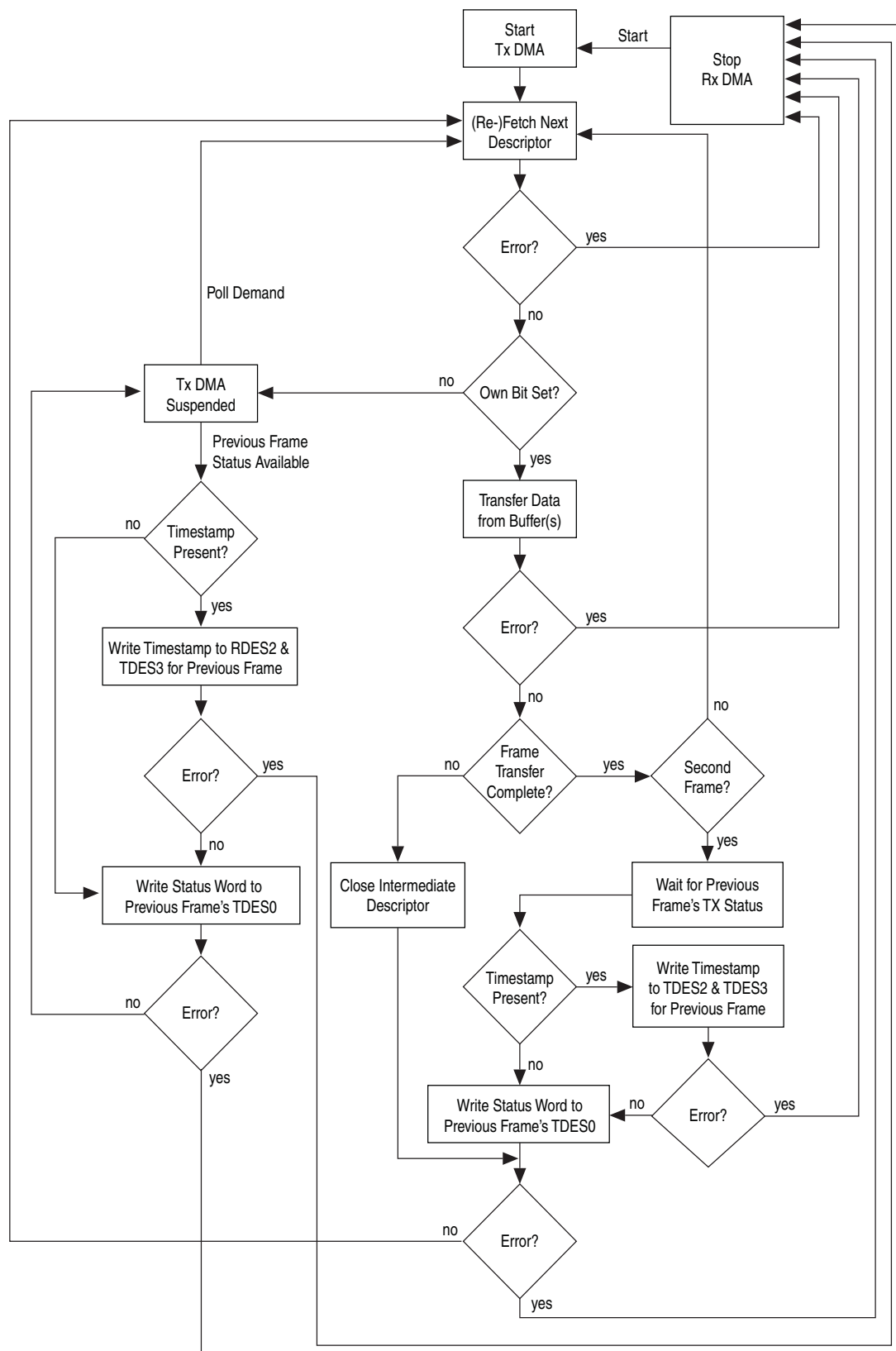
1. The DMA operates as described in steps 1–6 of “TX DMA Operation: Default (Non-OSF) Mode” on page 17–25. †
2. Without closing the previous frame's last descriptor, the DMA fetches the next descriptor. †
3. If the DMA owns the acquired descriptor, the DMA decodes the transmit buffer address in this descriptor. If the DMA does not own the descriptor, the DMA goes into Suspend mode and skips to Step 7. †
4. The DMA fetches the transmit frame from the Host memory and transfers the frame to the MTL until the End-of-frame data is transferred, closing the intermediate descriptors if this frame is split across multiple descriptors. †
5. The DMA waits for the previous frame's frame transmission status and timestamp. Once the status is available, the DMA writes the timestamp to TDES2 and TDES3, if such timestamp was captured (as indicated by a status bit). The DMA then writes the status, with a cleared Own bit, to the corresponding TDES0, thus closing the descriptor. If timestamping was not enabled for the previous frame, the DMA does not alter the contents of TDES2 and TDES3. †
6. If enabled, the transmit interrupt is set, the DMA fetches the next descriptor, then proceeds to Step 3 (when Status is normal). If the previous transmission status shows an underflow error, the DMA goes into Suspend mode (Step 7). †
7. In Suspend mode, if a pending status and timestamp are received from the MTL, the DMA writes the timestamp (if enabled for the current frame) to TDES2 and TDES3, then writes the status to the corresponding TDES0. It then sets relevant interrupts and returns to Suspend mode. †
8. The DMA can exit Suspend mode and enter the Run state (go to Step 1 or Step 2 depending on pending status) only after receiving a Transmit Poll demand (Register 1 (Transmit Poll Demand Register)). †



As the DMA fetches the next descriptor in advance before closing the current descriptor, the descriptor chain should have more than two different descriptors for correct and proper operation. †

The basic flow is described in Figure 17–8. †

Figure 17-8. TX DMA Operation in OSF Mode



Transmit Frame Processing

The transmit DMA expects that the data buffers contain complete Ethernet frames, excluding preamble, pad bytes, and FCS fields. The DA, SA, and Type/Len fields contain valid data. If the transmit descriptor indicates that the MAC must disable CRC or PAD insertion, the buffer must have complete Ethernet frames (excluding preamble), including the CRC bytes. †

Frames can be data-chained and can span several buffers. Frames must be delimited by the First Descriptor (TDES1[29]) and the Last Descriptor (TDES1[30]), respectively. †

As transmission starts, the First Descriptor must have (TDES1[29]) set. When this occurs, frame data transfers from the Host buffer to the MTL transmit FIFO buffer. Concurrently, if the current frame has the Last Descriptor (TDES1[30]) clear, the transmit Process attempts to acquire the Next descriptor. The transmit Process expects this descriptor to have TDES1[29] clear. If TDES1[30] is clear, it indicates an intermediary buffer. If TDES1[30] is set, it indicates the last buffer of the frame. †

After the last buffer of the frame has been transmitted, the DMA writes back the final status information to the Transmit Descriptor 0 (TDES0) word of the descriptor that has the last segment set in Transmit Descriptor 1 (TDES1[30]). At this time, if Interrupt on Completion (TDES1[31]) is set, the Bit 0 (Transmit Interrupt) of Register 5 (Status Register) is set, the Next descriptor is fetched, and the process repeats. †

The actual frame transmission begins after the MTL transmit FIFO buffer has reached either a programmable transmit threshold (Bits [16:14] of Register 6 (Operation Mode Register)), or a full frame is contained in the FIFO buffer. There is also an option for Store and Forward Mode (Bit 21 of Register 6 (Operation Mode Register)). Descriptors are released (Own bit TDES0[31] clears) when the DMA finishes transferring the frame. †



To ensure proper transmission of a frame and the next frame, you must specify a non-zero buffer size for the transmit descriptor that has the Last Descriptor (TDES1[30]) set. †

Transmit Polling Suspended

Transmit polling can be suspended by either of the following conditions: †

- The DMA detects a descriptor owned by the Host (TDES0[31]=0). To resume, the driver must give descriptor ownership to the DMA and then issue a Poll Demand command. †
- A frame transmission is aborted when a transmit error because of underflow is detected. The appropriate Transmit Descriptor 0 (TDES0) bit is set. †

If the DMA goes into SUSPEND state because of the first condition, then both Bit 16 (Normal Interrupt Summary) and Bit 2 (Transmit Buffer Unavailable) of Register 5 (Status Register) are set. If the second condition occurs, both Bit 15 (Abnormal Interrupt Summary) and Bit 5 (Transmit Underflow) of Register 5 (Status Register) are set, and the information is written to Transmit Descriptor 0, causing the suspension. †

In both cases, the position in the transmit List is retained. The retained position is that of the descriptor following the Last descriptor closed by the DMA. †

The driver must explicitly issue a Transmit Poll Demand command after rectifying the suspension cause. †

Reception

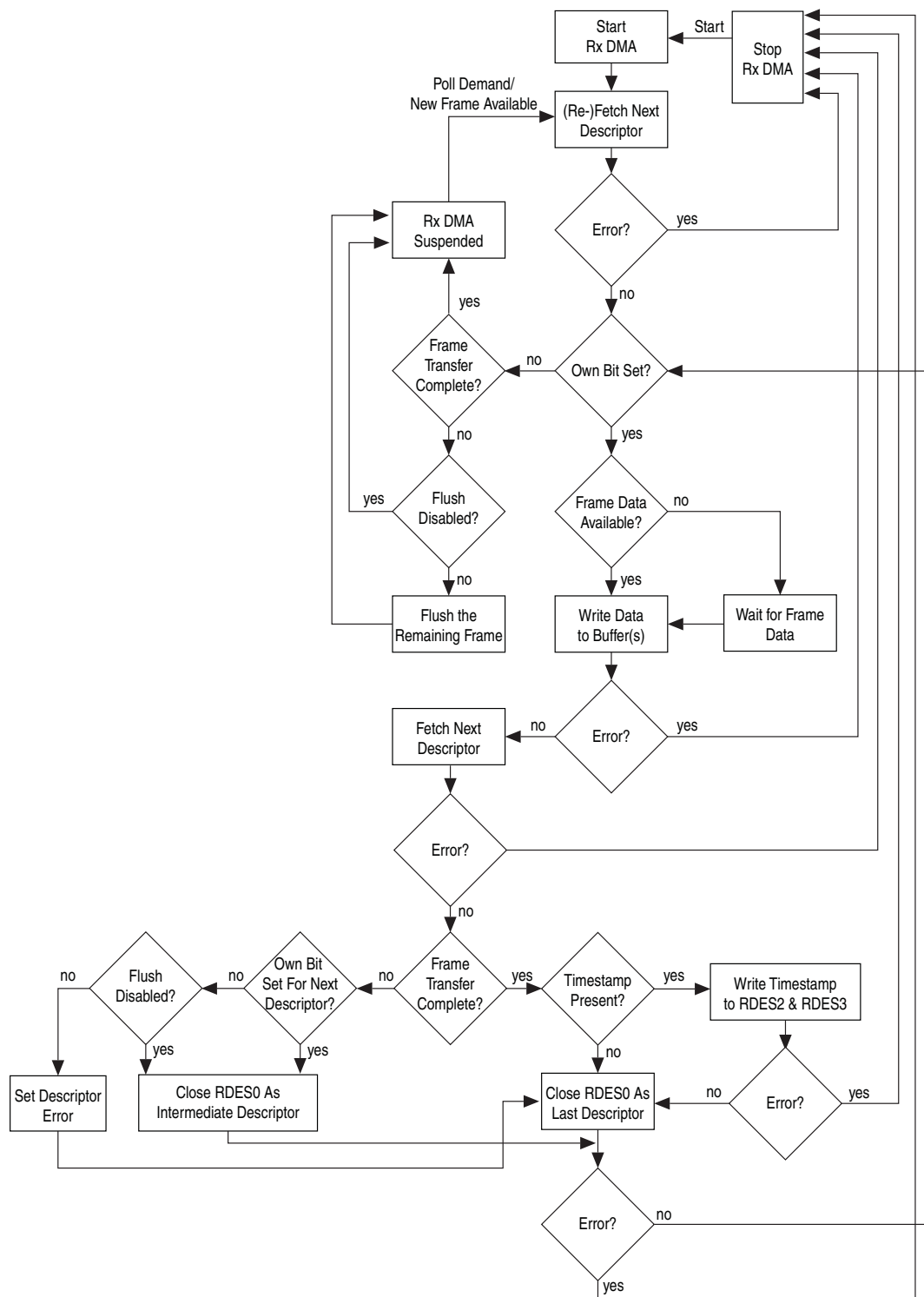
Receive functions use receive descriptors, described in detail in “Receive Descriptor” on page 17-40.

The receive DMA engine’s reception sequence is depicted in Figure 17-9 on page 17-32 and proceeds as follows: †

1. The host sets up receive descriptors (RDES0-RDES3) and sets the Own bit (RDES0[31]). †
2. When Bit 1 (SR) of Register 6 (Operation Mode Register) is set, the DMA enters the Run state. While in the Run state, the DMA polls the receive descriptor list, attempting to acquire free descriptors. If the fetched descriptor is not free (is owned by the host), the DMA enters the Suspend state and jumps to Step 9. †
3. The DMA decodes the receive data buffer address from the acquired descriptors. †
4. Incoming frames are processed and placed in the acquired descriptor’s data buffers. †
5. When the buffer is full or the frame transfer is complete, the receive engine fetches the next descriptor. †
6. If the current frame transfer is complete, the DMA proceeds to Step 7. If the DMA does not own the next fetched descriptor and the frame transfer is not complete (EOF is not yet transferred), the DMA sets the Descriptor Error bit in the RDES0 (unless flushing is disabled in Bit 24 of Register 6 (Operation Mode Register)). The DMA closes the current descriptor (clears the Own bit) and marks it as intermediate by clearing the Last Segment (LS) bit in the RDES0 value (marks it as Last Descriptor if flushing is not disabled), then proceeds to Step 8. If the DMA does own the next descriptor but the current frame transfer is not complete, the DMA closes the current descriptor as intermediate and reverts to Step 4. †
7. If IEEE 1588 timestamping is enabled, the DMA writes the timestamp (if available) to the current descriptor’s RDES2 and RDES3. It then takes the receive frame’s status from the MTL and writes the status word to the current descriptor’s RDES0, with the Own bit cleared and the Last Segment bit set. †
8. The receive engine checks the latest descriptor’s Own bit. If the host owns the descriptor (Own bit is 0), the Bit 7 (Receive Buffer Unavailable) of Register 5 (Status Register) is set and the DMA receive engine enters the Suspended state (Step 9). If the DMA owns the descriptor, the engine returns to Step 4 and awaits the next frame.
9. Before the receive engine enters the Suspend state, partial frames are flushed from the receive FIFO buffer. You can control flushing using Bit 24 of Register 6 (Operation Mode Register). †

10. The receive DMA exits the Suspend state when a Receive Poll demand is given or the start of next frame is available from the MTL's receive FIFO buffer. The engine proceeds to Step 2 and refetches the next descriptor. †

Figure 17-9. Receive DMA Operation



If software has enabled timestamping through CSR, when a valid timestamp value is not available for the frame (for example, because the receive FIFO buffer was full before the timestamp could be written to it), the DMA writes all-ones to RDES2 and RDES3. Otherwise (that is, if timestamping is not enabled), the RDES2 and RDES3 remain unchanged. †

Receive Descriptor Acquisition

The receive Engine always attempts to acquire an extra descriptor in anticipation of an incoming frame. Descriptor acquisition is attempted if any of the following conditions is satisfied: †

- Bit 1 (Start or Stop Receive) of Register 6 (Operation Mode Register) has been set immediately after being placed in the Run state. †
- The data buffer of current descriptor is full before the frame ends for the current transfer. †
- The controller has completed frame reception, but the current receive descriptor is not yet closed. †
- The receive process has been suspended because of a host-owned buffer ($RDES0[31] = 0$) and a new frame is received. †
- A Receive poll demand has been issued. †

Receive Frame Processing

The MAC transfers the received frames to the Host memory only when the frame passes the address filter and frame size is greater than or equal to configurable threshold bytes set for the receive FIFO buffer of MTL, or when the complete frame is written to the FIFO buffer in Store-and-Forward mode. †

If the frame fails the address filtering, it is dropped in the MAC block itself (unless Bit 31 (Receive All) of Register 1 (MAC Frame Filter) is set). Frames that are shorter than 64 bytes, because of collision or premature termination, can be removed from the MTL receive FIFO buffer. †

After 64 (configurable threshold) bytes have been received, the MTL block requests the DMA block to begin transferring the frame data to the receive Buffer pointed by the current descriptor. The DMA sets First Descriptor ($RDES0[9]$) after the DMA Host interface becomes ready to receive a data transfer (if DMA is not fetching transmit data from the host), to delimit the frame. The descriptors are released when the Own ($RDES[31]$) bit is reset to 0, either as the Data buffer fills up or as the last segment of the frame is transferred to the receive buffer. If the frame is contained in a single descriptor, both Last Descriptor ($RDES[8]$) and First Descriptor ($RDES[9]$) are set.

The DMA fetches the next descriptor, sets the Last Descriptor ($RDES[8]$) bit, and releases the $RDES0$ status bits in the previous frame descriptor. Then the DMA sets the Bit 6 (Receive Interrupt) of Register 5 (Status Register). The same process repeats unless the DMA encounters a descriptor flagged as being owned by the host. If this occurs, the receive Process sets the Bit 7 (Receive Buffer Unavailable) of Register 5 (Status Register) and then enters the Suspend state. The position in the receive list is retained. †

Receive Process Suspended

If a new receive frame arrives while the receive Process is in Suspend state, the DMA refetches the current descriptor in the Host memory. If the descriptor is now owned by the DMA, the receive Process re-enters the Run state and starts frame reception. If the descriptor is still owned by the host, by default, the DMA discards the current frame at the top of the MTL RX FIFO buffer and increments the missed frame counter. If more than one frame is stored in the MTL EX FIFO buffer, the process repeats. †

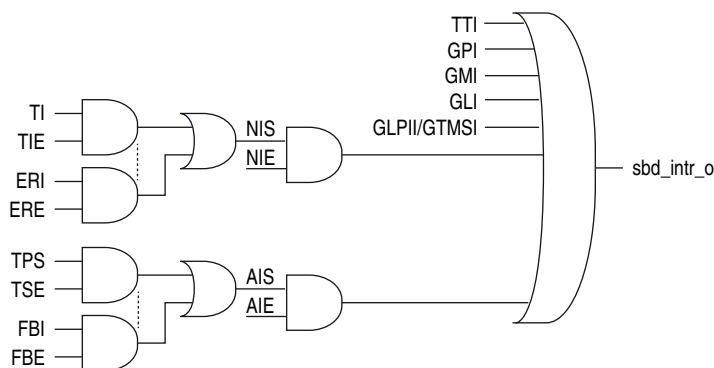
The discarding or flushing of the frame at the top of the MTL EX FIFO buffer can be avoided by disabling Flushing (Bit 24 of Register 6 (Operation Mode Register)). In such conditions, the receive process sets the Receive Buffer Unavailable status and returns to the Suspend state. †

Interrupts

Interrupts can be generated as a result of various events. The DMA Register 5 (Status Register) contains all the bits that might cause an interrupt. Register 7 (Interrupt Enable Register) contains an enable bit for each of the events that can cause an interrupt. †

There are two groups of interrupts, Normal and Abnormal, as described in Register 5 (Status Register). Interrupts are cleared by writing a 1 to the corresponding bit position. When all the enabled interrupts within a group are cleared, the corresponding summary bit is cleared. When both the summary bits are cleared, the `sbd_intr_o` interrupt signal is de-asserted. If the MAC is the cause for assertion of the interrupt, then any of the GLL, GMI, GPI, TTI, or GLPII bits of Register 5 (Status Register) are set high, as shown in Figure 17-10.

Figure 17-10. `sbd_intr_o` Generation ⁽¹⁾



Note to Figure 17-10:

(1) Signals NIS and AIS are registered.



The Register 5 (Status Register) is the interrupt status register. The interrupt pin (`sbd_intr_o`) is asserted because of any event in this status register only if the corresponding interrupt enable bit is set in Register 7 (Interrupt Enable Register). †

Interrupts are not queued and if the interrupt event occurs before the driver has responded to it, no additional interrupts are generated. For example, Bit 6 (Receive Interrupt) of Register 5 (Status Register) indicates that one or more frames were transferred to the Host buffer. The driver must scan all descriptors, from the last recorded position to the first one owned by the DMA. †

An interrupt is generated only once for simultaneous, multiple events. The driver must scan the Register 5 (Status Register) for the cause of the interrupt. The interrupt is not generated again unless a new interrupting event occurs, after the driver has cleared the appropriate bit in Register 5 (Status Register). For example, the controller generates a Bit 6 (Receive Interrupt) of Register 5 (Status Register) and the driver begins reading Register 5 (Status Register). Next, Bit 7 (Receive Buffer Unavailable) of Register 5 (Status Register) occurs. The driver clears the receive interrupt. Even then, the `sbd_intr_o` signal is not de-asserted, because of the active or pending Receive Buffer Unavailable interrupt. †

Bits 7:0 (Interrupt Timer) of Register 9 (Receive Interrupt Watchdog Timer Register) is given for flexible control of receive Interrupt. When this Interrupt timer is programmed with a non-zero value, it gets activated as soon as the RX DMA completes a transfer of a received frame to system memory without asserting the receive Interrupt because it is not enabled in the corresponding Receive Descriptor (RDES1[31] in [Table 17-12 on page 17-43](#)). When this timer runs out as per the programmed value, RI bit is set and the interrupt is asserted if the corresponding RI is enabled in Register 7 (Interrupt Enable Register). This timer gets disabled before it runs out, when a frame is transferred to memory and the RI is set because it is enabled for that descriptor. †

Error Response to DMA

For any data transfer initiated by a DMA channel, if the slave replies with an error response, that DMA stops all operations and updates the error bits and the Fatal Bus Error bit in the Register 5 (Status Register). The DMA controller can resume operation only after soft resetting or hard resetting the EMAC and reinitializing the DMA.

Descriptor Overview

This section describes the HPS EMAC DMA descriptors.

The DMA in the Ethernet subsystem transfers data based on a linked list of descriptors, as explained in [“DMA Controller” on page 17-21](#). The descriptors are created in the system memory. The EMAC DMA supports the following two types of descriptors:

- Normal descriptor—This is the default descriptor format which can have 4 DWORDS. For information about this descriptor type, refer to [“Normal Descriptor” on page 17-36](#). †
- Enhanced descriptor—This is the alternate descriptor format which can have 8 DWORDS (32 bytes). For information about this descriptor type, refer to [“Alternate or Enhanced Descriptors” on page 17-47](#).

Each descriptor contains two buffers, two byte-count buffers, and two address pointers, which enable the adapter port to be compatible with various types of memory management schemes. Once configured, you cannot change the descriptor structure. †

Descriptor Endianness

The descriptor addresses must be aligned to the used bus width (Word, DWord, or LWord for 32-bit, 64-bit, or 128-bit bus respectively). The data bus is configured as little-endian.



The figures in this section show the normal transmit and receive descriptors. If you are using the enhanced descriptors, you must ensure that the descriptors are created accordingly in system memory. For more information about enhanced descriptors, refer to [“Alternate or Enhanced Descriptors” on page 17-47](#). †

Normal Descriptor

This is the default descriptor format which can have 4 DWORDS. You can use this descriptor format when advanced features such as IEEE 1588 advanced timestamping are not enabled.

Transmit Descriptor

The DMA in the EMAC requires at least one descriptor for a transmit frame. In addition to two buffers, two byte-count buffers, and two address pointers, the transmit descriptor has control fields which can be used to control the MAC operation on per-transmit frame basis.

Transmit Descriptor 0 (TDES0)

TDES0 contains the transmitted frame status and the descriptor ownership information.

Table 17-6. Transmit Descriptor 0 (Part 1 of 3)

Bit	Description
31	OWN: Own Bit When set, this bit indicates that the descriptor is owned by the DMA. When this bit is reset, it indicates that the descriptor is owned by the Host. The DMA clears this bit either when it completes the frame transmission or when the buffers allocated in the descriptor are empty. The ownership bit of the First descriptor of the frame should be set after all subsequent descriptors belonging to the same frame have been set. This avoids a possible race condition between fetching a descriptor and the driver setting an ownership bit. †
30:18	Reserved †
17	TTSS: TX Timestamp Status This status bit indicates that a timestamp has been captured for the corresponding transmit frame. When this bit is set, TDES2 and TDES3 have timestamp values that were captured for the transmit frame. This field is valid only when the Last Segment control bit (TDES1[30]) in a descriptor is set.
16	IHE: IP Header Error When set, this bit indicates that the Checksum Offload engine detected an IP header error and consequently did not modify the transmitted frame for any checksum insertion.

Table 17–6. Transmit Descriptor 0 (Part 2 of 3)

Bit	Description
15	<p>ES: Error Summary</p> <p>Indicates the logical OR of the following bits:</p> <ul style="list-style-type: none"> ■ TDES0[16]: IP Header Error ■ TDES0[14]: Jabber Timeout ■ TDES0[13]: Frame Flush ■ TDES0[12]: Payload Checksum Error ■ TDES0[11]: Loss of Carrier ■ TDES0[10]: No Carrier ■ TDES0[9]: Late Collision ■ TDES0[8]: Excessive Collision ■ TDES0[2]: Excessive Deferral ■ TDES0[1]: Underflow Error †
14	<p>JT: Jabber Timeout</p> <p>When set, this bit indicates that the MAC transmitter has experienced a jabber time-out. This bit is only set when the JD bit of Register 0 (MAC Configuration Register) is not set. †</p>
13	<p>FF: Frame Flushed</p> <p>When set, this bit indicates that the DMA or MAC transaction layer (MTL) flushed the frame because of a software flush command given by the CPU. †</p>
12	<p>12 PCE: Payload Checksum Error</p> <p>This bit, when set, indicates that the Checksum Offload engine had a failure and did not insert any checksum into the encapsulated TCP, UDP, or ICMP payload. This failure can be either because of insufficient bytes, as indicated by the IP Header's Payload Length field, or the MTL starting to forward the frame to the MAC transmitter in Store-and-Forward mode without the checksum having been calculated yet. This second error condition only occurs when the transmit FIFO buffer depth is less than the length of the Ethernet frame being transmitted to avoid deadlock, the MTL starts forwarding the frame when the FIFO buffer is full, even in the store-and-forward mode.</p>
11	<p>LC: Loss of Carrier</p> <p>When set, this bit indicates that Loss of Carrier occurred during frame transmission (that is, the <code>gmii_crs_i</code> signal was inactive for one or more transmit clock periods during frame transmission). This is valid only for the frames transmitted without collision and when the MAC operates in the half-duplex mode. †</p>
10	<p>NC: No Carrier</p> <p>When set, this bit indicates that the carrier sense signal from the PHY was not asserted during transmission. †</p>
9	Reserved
8	<p>EC: Excessive Collision</p> <p>When set, this bit indicates that the transmission was aborted after 16 successive collisions while attempting to transmit the current frame. If Bit 9 (Disable Retry) in Register 0 (MAC Configuration Register) is set, this bit is set after the first collision and the transmission of the frame is aborted. †</p>
7	<p>VF: VLAN Frame</p> <p>When set, this bit indicates that the transmitted frame was a VLAN-type frame. †</p>
6:3	<p>CC: Collision Count</p> <p>This 4-bit counter value indicates the number of collisions occurring before the frame was transmitted. The count is not valid when the Excessive Collisions bit (TDES0[8]) is set. †</p>

Table 17–6. Transmit Descriptor 0 (Part 3 of 3)

Bit	Description
2	ED: Excessive Deferral When set, this bit indicates that the transmission has ended because of excessive deferral of over 24,288 bit times (155,680 bits times in 1000-Mbps mode, or in Jumbo frame enabled mode) if Bit 4 (Deferral Check) is set high in Register 0 (MAC Configuration Register). †
1	UF: Underflow Error When set, this bit indicates that the MAC aborted the frame because data arrived late from the Host memory. Underflow Error indicates that the DMA encountered an empty transmit Buffer while transmitting the frame. The transmission process enters the suspended state and sets both Transmit Underflow (Register 5[5]) and Transmit Interrupt (Register 5[0]). †
0	DB: Deferred Bit When set, this bit indicates that the MAC defers before transmission because of the presence of carrier. This bit is valid only in the half-duplex mode. †

Transmit Descriptor 1 (TDES1)

TDES1 contains the buffer sizes and other bits which control the descriptor chain or ring and the frame being transferred. †



Refer to “[Buffer Size Calculations](#)” on page 17–24 for further detail on calculating buffer sizes. †

Table 17–7. Transmit Descriptor 1 (Part 1 of 2)

Bit	Description
31	IC: Interrupt on Completion When set, this bit sets Transmit Interrupt (Register 5[0]) after the present frame has been transmitted. †
30	LS: Last Segment When set, this bit indicates that the buffer contains the last segment of the frame. When this bit is set, the TBS1 or TBS2 field should have a non-zero value. †
29	FS: First Segment When set, this bit indicates that the buffer contains the first segment of a frame. †
28:27	CIC: Checksum Insertion Control These bits control the insertion of checksums in Ethernet frames that encapsulate TCP, UDP, or ICMP over IPv4 or IPv6 as described below. <ul style="list-style-type: none"> ■ 0: Do nothing. Checksum Engine is bypassed ■ 1: Insert IPv4 header checksum. Use this value to insert IPv4 header checksum when the frame encapsulates an IPv4 datagram. ■ 2: Insert TCP/UDP/ICMP checksum. The checksum is calculated over the TCP, UDP, or ICMP segment only and the TCP, UDP, or ICMP pseudo-header checksum is assumed to be present in the corresponding input frame's Checksum field. An IPv4 header checksum is also inserted if the encapsulated datagram conforms to IPv4. ■ 3: Insert a TCP/UDP/ICMP checksum that is fully calculated in this engine. In other words, the TCP, UDP, or ICMP pseudo-header is included in the checksum calculation, and the input frame's corresponding Checksum field has an all-zero value. An IPv4 Header checksum is also inserted if the encapsulated datagram conforms to IPv4. The Checksum engine detects whether the TCP, UDP, or ICMP segment is encapsulated in IPv4 or IPv6 and processes its data accordingly.

Table 17-7. Transmit Descriptor 1 (Part 2 of 2)

Bit	Description
26	DC: Disable CRC When set, the MAC does not append the CRC to the end of the transmitted frame. This is valid only when the first segment (TDES1[29]) is set. †
25	TER: Transmit End of Ring When set, this bit indicates that the descriptor list reached its final descriptor. The returns to the base address of the list, creating a descriptor ring. †
24	TCH: Second Address Chained When set, this bit indicates that the second address in the descriptor is the Next descriptor address rather than the second buffer address. When TDES1[24] is set, TBS2 (TDES1[21-11]) are “don’t care” values. TDES1[25] takes precedence over TDES1[24]. †
23	DP: Disable Padding When set, the MAC does not automatically add padding to a frame shorter than 64 bytes. When this bit is reset, the DMA automatically adds padding and CRC to a frame shorter than 64 bytes and the CRC field is added despite the state of the DC (TDES1[26]) bit. This is valid only when the first segment (TDES1[29]) is set. †
22	TTSE: Transmit Timestamp Enable When set, this bit enables IEEE1588 hardware timestamping for the transmit frame referenced by the descriptor. This field is valid only when the First Segment control bit (TDES1[29]) is set. †
21:11	TBS2: Transmit Buffer 2 Size These bits indicate the second Data Buffer in bytes. This field is not valid if TDES1[24] is set. †
10:0	TBS1: Transmit Buffer 1 Size These bits indicate the First Data Buffer byte size. If this field is 0, the DMA ignores this buffer and uses Buffer 2 or next descriptor depending on the value of TCH (Bit 24). †

Transmit Descriptor 2 (TDES2)

TDES2 contains the address pointer to the first buffer of the descriptor. †

Table 17-8. Transmit Descriptor 2

Bit	Description
31:0	Buffer 1 Address Pointer These bits indicate the physical address of Buffer 1. There is no limitation on the buffer address alignment. Refer to “Host Data Buffer Alignment” on page 17-24 for further detail on buffer address alignment. †

Transmit Descriptor 3 (TDES3)

TDES3 contains the address pointer either to the second buffer of the descriptor or the next descriptor. †

Table 17-9. Transmit Descriptor 3

Bit	Description
31:0	Buffer 2 Address Pointer (Next Descriptor Address) Indicates the physical address of Buffer 2 when a descriptor ring structure is used. If the Second Address Chained (TDES1[24]) bit is set, this address contains the pointer to the physical memory where the Next descriptor is present. The buffer address pointer must be aligned to the bus width only when TDES1[24] is set. (LSBs are ignored internally.) †

Receive Descriptor

The DMA in the EMAC requires at least two descriptors when receiving a frame. The receive state machine of the DMA always attempts to acquire an extra descriptor in anticipation of an incoming frame. (The size of the incoming frame is unknown). Before the RX DMA closes a descriptor, it attempts to acquire the next descriptor even if no frames are received.

In a single descriptor (receive) system, the subsystem generates a descriptor error if receive buffer is unable to accommodate the incoming frame and the next descriptor is not owned by the DMA. Thus, the Host is forced to increase either its descriptor pool or the buffer size. Otherwise, the subsystem starts dropping all incoming frames. †

Receive Descriptor 0 (RDES0)

RDES0 contains the received frame status, the frame length, and the descriptor ownership information.

Table 17-10. Receive Descriptor 0 (Part 1 of 3)

Bit	Description
31	OWN: Own Bit When set, this bit indicates that the descriptor is owned by the DMA of the EMAC. When this bit is reset, this bit indicates that the descriptor is owned by the Host. The DMA clears this bit either when it completes the frame reception or when the buffers that are associated with this descriptor are full.
30	AFM: Destination Address Filter Fail When set, this bit indicates a frame that failed in the DA Filter in the MAC. †
29:16	FL: Frame Length These bits indicate the byte length of the received frame that was transferred to host memory (including CRC). This field is valid when Last Descriptor (RDES0[8]) is set and either the Descriptor Error (RDES0[14]) or Overflow Error bit is reset. The frame length also includes the two bytes appended to the Ethernet frame when IP checksum calculation (Type 1) is enabled and the received frame is not a MAC control frame. This field is valid when Last Descriptor (RDES0[8]) is set. When the Last Descriptor and Error Summary bits are not set, this field indicates the accumulated number of bytes that have been transferred for the current frame. †
15	ES: Error Summary Indicates the logical OR of the following bits: <ul style="list-style-type: none"> ■ RDES0[0]: Payload Checksum Error ■ RDES0[1]: CRC Error ■ RDES0[3]: Receive Error ■ RDES0[4]: Watchdog Timeout ■ RDES0[6]: Late Collision ■ RDES0[7]: IPC Checksum (Type 2) ■ RDES0[11]: Overflow Error ■ RDES0[14]: Descriptor Error This field is valid only when the Last Descriptor (RDES0[8]) is set. †
14	DE: Descriptor Error When set, this bit indicates a frame truncation caused by a frame that does not fit within the current descriptor buffers, and that the DMA does not own the Next descriptor. The frame is truncated. This field is valid only when the Last Descriptor (RDES0[8]) is set. †

Table 17–10. Receive Descriptor 0 (Part 2 of 3)

Bit	Description
13	SAF: Source Address Filter Fail When set, this bit indicates that the SA field of frame failed the SA Filter in the MAC. †
12	LE: Length Error When set, this bit indicates that the actual length of the frame received and that the Length/ Type field does not match. This bit is valid only when the Frame Type (RDES0[5]) bit is reset. Length error status is not valid when CRC error is present. †
11	OE: Overflow Error When set, this bit indicates that the received frame is damaged because of buffer overflow in RX FIFO buffer. Note: This bit is set only when the DMA transfers a partial frame to the application. This happens only when the RX FIFO buffer is operating in the threshold mode. In the store-and-forward mode, all partial frames are dropped completely in RX FIFO buffer. †
10	VLAN: VLAN Tag When set, this bit indicates that the frame pointed to by this descriptor is a VLAN frame tagged by the MAC. The VLAN tagging depends on checking VLAN fields of the received frame based on the Register 7 (VLAN Tag Register) settings. †
9	FS: First Descriptor When set, this bit indicates that this descriptor contains the first buffer of the frame. If the size of the first buffer is 0, the second buffer contains the beginning of the frame. If the size of the second buffer is also 0, the next descriptor contains the beginning of the frame. †
8	LS: Last Descriptor When set, this bit indicates that the buffers pointed to by this descriptor are the last buffers of the frame †
7	IPC Checksum Error When IP Checksum Engine (Type 1) is enabled, this bit, when set, indicates that the 16-bit IPv4 Header checksum calculated by the MAC did not match the received checksum bytes. Bit 15 (ES) is NOT set when this bit is set in this mode. If this bit is set when Full Checksum Offload Engine (Type 2) is enabled, it indicates an error in the IPv4 or IPv6 header. This error can be due to inconsistent Ethernet Type field and IP header Version field values, a header checksum mismatch in IPv4, or an Ethernet frame lacking the expected number of IP header bytes. For more information, refer to Table 17–11 on page 17–42 .
6	LC: Late Collision When set, this bit indicates that a late collision has occurred while receiving the frame in half-duplex mode. †
5	FT: Frame Type When set, this bit indicates that the receive frame is an Ethernet-type frame (the LT field is greater than or equal to 0x0600). When this bit is reset, it indicates that the received frame is an IEEE802.3 frame. This bit is not valid for Runt frames less than 14 bytes. For more information, refer to Table 17–11 on page 17–42 . †
4	RWT: Receive Watchdog Timeout When set, this bit indicates that the receive Watchdog Timer has expired while receiving the current frame and the current frame is truncated after the Watchdog Timeout. †
3	RE: Receive Error When set, this bit indicates that the <code>gmii_rxer_i</code> signal is asserted while <code>gmii_rxdv_i</code> is asserted during frame reception. Error can be of less or no extension, or error (<code>rx! = 0xf</code>) during extension. †
2	DE: Dribble Bit Error When set, this bit indicates that the received frame has a non-integer multiple of bytes (odd nibbles). This bit is valid only in MII Mode. †

Table 17-10. Receive Descriptor 0 (Part 3 of 3)

Bit	Description
1	CE: CRC Error When set, this bit indicates that a CRC error occurred on the received frame. This field is valid only when the Last Descriptor (RDES0[8]) is set. †
0	RX MAC Address or Payload Checksum Error When set, this bit indicates that the RX MAC Address registers value (1 to 15) matched the frame's DA field. When reset, this bit indicates that the RX MAC Address Register 0 value matched the DA field. If Full Checksum Offload Engine is enabled, this bit, when set, indicates the TCP, UDP, or ICMP checksum the EMAC calculated does not match the received encapsulated TCP, UDP, or ICMP segment's Checksum field. This bit is also set when the received number of payload bytes does not match the value indicated in the Length field of the encapsulated IPv4 or IPv6 datagram in the received Ethernet frame. For more information, refer to Table 17-11 on page 17-42 . †

When the Full Checksum Offload Engine (Type 2) is enabled, the permutations of Bits 5, 7, and 0 reflect the conditions discussed in [Table 17-11](#). †

Table 17-11. Receive Descriptor 0 when COE (Type 2) is Enabled

Bit 5: Frame Type	Bit 7: IPC Checksum Error	Bit 0: Payload Checksum Error	Frame Status
0	0	0	IEEE 802.3 Type frame (Length field value is less than 0x0600.) †
1	0	0	IPv4/IPv6 Type frame, no checksum error detected †
1	0	1	IPv4/IPv6 Type frame with a payload checksum error (as described for PCE) detected †
1	1	0	IPv4/IPv6 Type frame with an IP header checksum error (as described for IPC CE) detected †
1	1	1	IPv4/IPv6 Type frame with both IP header and payload checksum errors detected †
0	0	1	IPv4/IPv6 Type frame with no IP header checksum error and the payload check bypassed, due to an unsupported payload †
0	1	1	A Type frame that is neither IPv4 or IPv6 (the Checksum Offload engine bypasses checksum completely.) †
0	1	0	Reserved †

Receive Descriptor 1 (RDES1)

RDES1 contains the buffer sizes and other bits that control the descriptor chain or ring. †


 For more information about calculating buffer sizes, refer to “[Buffer Size Calculations](#)” on page 17-24. †

Table 17-12. Receive Descriptor 1

Bit	Description
31	Disable Interrupt on Completion When set, this bit prevents the setting of the bit 6 (RI) of the Register 5 (Status Register) for the received frame that ends in the buffer pointed to by this descriptor. This, in turn, disables the assertion of the interrupt to Host due to RI for that frame. †
30:26	Reserved †
25	RER: Receive End of Ring When set, this bit indicates that the descriptor list reached its final descriptor. The DMA returns to the base address of the list, creating a descriptor Ring. †
24	RCH: Second Address Chained When set, this bit indicates that the second address in the descriptor is the Next descriptor address rather than the second buffer address. When RDES1[24] is set, RBS2 (RDES1[21-11]) is a “don’t care” value. RDES1[25] takes precedence over RDES1[24]. †
23:22	Reserved †
21:11	RBS2: Receive Buffer 2 Size These bits indicate the second data buffer size in bytes. The buffer size must be a multiple of 4, even if the value of RDES3 (buffer2 address pointer) is not aligned to bus width. In the case where the buffer size is not a multiple of 4, the resulting behavior is undefined. This field is not valid if RDES1[24] is set.
10:0	RBS1: Receive Buffer 1 Size Indicates the first data buffer size in bytes. The buffer size must be a multiple of 4, even if the value of RDES2 (buffer1 address pointer) is not aligned. In the case where the buffer size is not a multiple of 4, the resulting behavior is undefined. If this field is 0, the DMA ignores this buffer and uses Buffer 2 or next descriptor depending on the value of RCH (Bit 24).

Receive Descriptor 2 (RDES2)

RDES2 contains the address pointer to the first data buffer in the descriptor. †


 For more information about buffer address alignment, refer to “[Host Data Buffer Alignment](#)” on page 17-24. †

Table 17-13. Receive Descriptor 2 (Default Operation)

Bit	Description
31:0	Buffer 1 Address Pointer These bits indicate the physical address of Buffer 1. There are no limitations on the buffer address alignment except for the following condition: The DMA uses the value programmed in RDES2[1:0] for its address generation when the RDES2 value is used to store the start of frame. The DMA performs a write operation with the RDES2[1:0] bits as 0 during the transfer of the start of frame but the frame data is shifted as per the actual Buffer address pointer. The DMA ignores RDES2[1:0], if the address pointer is to a buffer where the middle or last part of the frame is stored.

Receive Descriptor 3 (RDES3)

RDES3 contains the address pointer either to the second data buffer in the descriptor or to the next descriptor. †

Table 17-14. Receive Descriptor 3

Bit	Description
31:0	<p>Buffer 2 Address Pointer (Next Descriptor Address)</p> <p>These bits indicate the physical address of Buffer 2 when a descriptor ring structure is used. If the Second Address Chained (RDES1[24]) bit is set, this address contains the pointer to the physical memory where the Next descriptor is present.</p> <p>If RDES1[24] is set, the buffer (Next descriptor) address pointer must be bus width-aligned (RDES3[1:0] = 0. LSBs are ignored internally.) However, when RDES1[24] is reset, there are no limitations on the RDES3 value, except for the following condition: The DMA uses the value programmed in RDES3[1:0] for its buffer address generation when the RDES3 value is used to store the start of frame. The DMA ignores RDES3[1:0], if the address pointer is to a buffer where the middle or last part of the frame is stored.</p>

Descriptor Format With IEEE 1588-2005 Timestamps Enabled

The default descriptor format (as described in “[Transmit Descriptor](#)” on page 17-36 and “[Receive Descriptor](#)” on page 17-40), and field descriptions remain unchanged when created by software (Own bit is set in DES0). †

However, if the software has enabled IEEE 1588-2005 functionality, the DES2 and DES3 descriptor fields (refer to [Table 17-15](#)) take on a different meaning when the DMA closes the descriptor (Own bit in DES0 is cleared). †

The DMA updates the DES2 and DES3 with the timestamp value before clearing the Own bit in DES0. When the EMAC is operating in 32-bit mode, DES2 is updated with the lower 32 timestamp bits (the Sub-second field, called TSL in subsequent sections) and DES3 is updated with the upper 32 timestamp bits (the seconds field, called TSH in subsequent sections).

Table 17-15. Descriptor Fields when DMA Clears the Own Bit

	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
DES0																																
DES1																																
DES2	Timestamp Low [31:0]																															
DES3	Timestamp High [31:0]																															

The following sections describe the details specific to receive and transmit descriptors in this mode. †

Transmit Descriptor

In addition to the changes described in “[Descriptor Format With IEEE 1588-2005 Timestamps Enabled](#)” on page 17-44, the transmit descriptor has additional control and status bits (TTSE and TTSS, respectively) for timestamping, as shown in [Table 17-16](#). Software sets the TTSE bit (when the Own bit is set), instructing the EMAC to generate a timestamp for the corresponding Ethernet frame being transmitted. The DMA sets the TTSS bit if the timestamp has been updated in the TDES2 and TDES3 fields when the descriptor is closed (Own bit is cleared).

Table 17-16. Transmit Descriptor Fields - Normal Format

	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
TDES0	O W N	RES														T T S S	Status [16:0]															
TDES1	Other Control Fields									T T S E	Buffer 2Byte Count [21:11]										Buffer 1 Byte Count [10:0]											
TDES2	TTSL																															
TDES3	TTSH																															

Transmit Timestamp Control and Status Fields

The position of these fields is different for normal transmit descriptor and enhanced format transmit descriptor. The value of this field in both the cases shall be preserved by the DMA at the time of closing the descriptor. †

Updates to [Table 17-14 on page 17-44](#) and [Table 17-6 on page 17-36](#) for the default (normal) descriptor format are described below. †

Table 17-17. Transmit Timestamp Status – Normal Descriptor Format Case (TDES0)

Bit	Description
17	TTSS: Transmit Timestamp Status This field is a status bit indicating that a timestamp was captured for the corresponding transmit frame. When this bit is set, both TDES2 and TDES3 have a timestamp value that was captured for the transmit frame. This field is valid only when the Last Segment control bit (TDES1[30] in the descriptor) is set. †

Table 17-18. Transmit Timestamp Control – Normal Descriptor Format Case (TDES1)

Bit	Description
22	TTSE: Transmit Timestamp Enable When set, this field enables IEEE1588 hardware timestamping for the transmit frame described by the descriptor. This field is valid only when the First Segment control bit (TDES1[29] in the descriptor) is set. †

Transmit Timestamp Field

The transmit descriptor format and field descriptions remain unchanged when they are created by software (when the Own bit is set). However, when the DMA closes the last descriptor (marked, in the alternative descriptor format, by the LS bit in TDES1 or TDES0) and IEEE 1588 functionality is enabled (the Own bit is cleared), the TDES2 and TDES3 descriptor fields are updated with the timestamp, if taken, for that frame. †

Table 17-19 and Table 17-20 describe the fields that have different meaning when the descriptor is closed. †

Table 17-19. Transmit Descriptor Fields (TDES2)

Bit	Description
31:0	TTSL: Transmit Frame Timestamp Low This field is updated by DMA with the least significant 32 bits of the timestamp captured for the corresponding transmit frame. This field has the timestamp only if the Last Segment control bit (LS) in the descriptor is set. †

Table 17-20. Transmit Descriptor Fields (TDES3)

Bit	Description
31:0	TTSH: Transmit Frame Timestamp High This field is updated by DMA with the most significant 32 bits of the timestamp captured for the corresponding transmit frame. This field has the timestamp only if the Last Segment control bit (LS) in the descriptor is set. †

Receive descriptor**Receive Timestamp**

Table 17-21 shows the format of receive descriptor when timestamping is enabled.

Table 17-21. Receive Timestamp Fields

	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
RDES0																																
RDES1																																
RDES2	Receive Frame Timestamp Low [31:0]																															
RDES3	Receive Frame Timestamp High [31:0]																															

Table 17-22 on page 17-47 and Table 17-23 on page 17-47 describe the fields that have different meaning for RDES2 and RDES3 when the receive descriptor is closed and timestamping is enabled.



When software disables the Timestamp feature (the TSENA bit in Register 448 is low), the DMA does not update the RDES2 or RDES3 fields of descriptor before closing the RDES0. †

Table 17-22. Receive Descriptor Fields (RDES2)

Bit	Description
31:0	RTSL: Receive Frame Timestamp Low The DMA updates this field with the least significant 32 bits of the timestamp captured for the corresponding receive frame. The DMA updates this field only for the last descriptor of the receive frame indicated by Last Descriptor status bit (RDES0[8]). When this field and the RTSH field in RDES3 show an all-ones value, the timestamp must be treated as corrupt. †

Table 17-23. Receive descriptor Fields (RDES3)

Bit	Description
31:0	RTSH: Receive Frame Timestamp High The DMA updates this field with the most significant 32 bits of the timestamp captured for the corresponding receive frame. The DMA updates this field only for the last descriptor of the receive frame indicated by Last Descriptor status bit (RDES0[8]). When this field and RDES2's RTSL field show all-ones values, the timestamp must be treated as corrupt. †

Alternate or Enhanced Descriptors

The alternate (or enhanced) descriptor structure can have 8 DWORDS (32-bytes) instead of the 4 DWORDS as in the case of normal descriptor format. The features of the alternate descriptor structure are:

- The normal descriptor structure allows data buffers of up to 2,048 bytes. The alternate descriptor structure is implemented to support buffers of up to 8 KB (useful for Jumbo frames).
- There is a re-assignment of control and status bits in TDES0, TDES1, RDES0 (advanced timestamp or IPC full offload configuration), and RDES1. †
- The transmit descriptor stores the timestamp in TDES6 and TDES7 when you select the advanced timestamp. †
- This receive descriptor structure is also used for storing the extended status (RDES4) and timestamp (RDES6 and RDES7) when advanced timestamp, IPC Full Checksum Offload Engine, or Layer 3 and Layer 4 filter feature is selected. †

- You can select one of the following options for descriptor structure:
 - If timestamping is enabled in Register 448 (Timestamp Control Register) or Checksum Offload is enabled in Register 0 (MAC Configuration Register), the software needs to allocate 32-bytes (8 DWORDS) of memory for every descriptor. For this, the software should set Bit 7 (Alternate Descriptor Size) of Register 0 (Bus Mode Register). †
 - If timestamping or Checksum Offload is not enabled, the extended descriptors (DES4 to DES7) are not required. Therefore, the software can use alternate descriptors with the default size of 16 bytes (4 DWORDS). For this, the software should reset Bit 7 (Alternate Descriptor Size) of Register 0 (Bus Mode Register) to 0. †
- When alternate descriptor is selected without Timestamp or Receive IPC Full Checksum Offload Engine (Type 2) feature, the descriptor size is always 4 DWORDs (DES0-DES3). Therefore, the software can use alternate descriptors with the default size of 16 bytes. †

Transmit Descriptor

The transmit descriptor structure is shown in [Table 17-24 on page 17-49](#). The application software must program the control bits TDES0[31:18] during descriptor initialization. When the DMA updates the descriptor, it write backs all the control bits except the OWN bit (which it clears) and updates the status bits[7:0]. The contents of the transmitter descriptor word 0 (TDES0) through word 3 (TDES3) are given in [Table 17-26 on page 17-50](#), [Table 17-27 on page 17-53](#), [Table 17-28 on page 17-53](#), and [Table 17-29 on page 17-53](#), respectively. †

With the advance timestamp support, the snapshot of the timestamp to be taken can be enabled for a given frame by setting Bit 25 (TTSE) of TDES0. When the descriptor is closed (that is, when the OWN bit is cleared), the timestamp is written into TDES6 and TDES7. This is indicated by the status Bit 17 (TTSS) of TDES0 shown in [Table 17-24 on page 17-49](#). The contents of TDES6 and TDES7 are mentioned in [Table 17-30 on page 17-53](#) and [Table 17-31 on page 17-53](#). †



When advanced timestamp feature is enabled, the software should set Bit 7 of Register 0 (Bus Mode Register), so that the DMA operates with extended descriptor size. When this control bit is reset, the TDES4-TDES7 descriptor space is not valid. †

Table 17-24. Transmit Descriptor Fields - Alternate (Enhanced) Format

	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	
TDES0	O W N	Ctrl [30:26]					T T S E	Ctrl [24:18]						T T S S	Status [16:7]								Ctrl/Status [6:3]				Status [2:0]						
TDES1	Ctrl [31:29]		Buffer 2Byte Count [28:16]												RES			Buffer 1 Byte Count [12:0]															
TDES2	Buffer 1 Address [31:0]																																
TDES3	Buffer 2 Address [31:0] or Next Descriptor Address [31:0]																																
TDES4	Reserved																																
TDES5	Reserved																																
TDES6	Transmit Timestamp Low [31:0]																																
TDES7	Transmit Timestamp High [31:0]																																

The DMA always reads or fetches four DWORDS of the descriptor from system memory to obtain the buffer and control information as shown in Table 17-25. †

Table 17-25. Transmit Descriptor Fetch (Read) for Alternate (Enhanced) Format

	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
TDES0	OWN	Ctrl [30:26]					TTSE	Ctrl [24:18]							Reserved for Status [17:7]										SLOT Number [6:3]			Reserved for Status [2:0]				
TDES1	Ctrl [31:29]		Buffer 2 Byte Count [28:16]												RES			Buffer 1 Byte Count [12:0]														
TDES2	Buffer 1 Address [31:0]																															
TDES3	Buffer 2 Address [31:0] or Next Descriptor Address [31:0]																															

Table 17-26. Transmit Descriptor Word 0 (TDES0) (Part 1 of 3)

Bit	Description
31	OWN: Own Bit When set, this bit indicates that the descriptor is owned by the DMA. When this bit is reset, it indicates that the descriptor is owned by the Host. The DMA clears this bit either when it completes the frame transmission or when the buffers allocated in the descriptor are read completely. The ownership bit of the frame's first descriptor must be set after all subsequent descriptors belonging to the same frame have been set. This avoids a possible race condition between fetching a descriptor and the driver setting an ownership bit. †
30	IC: Interrupt on Completion When set, this bit sets the Transmit Interrupt (Register 5[0]) after the present frame has been transmitted. †
29	LS: Last Segment When set, this bit indicates that the buffer contains the last segment of the frame. When this bit is set, the TBS1 or TBS2 field in TDES1 should have a non-zero value. †
28	FS: First Segment When set, this bit indicates that the buffer contains the first segment of a frame. †
27	DC: Disable CRC When this bit is set, the MAC does not append a CRC to the end of the transmitted frame. This is valid only when the first segment (TDES0[28]) is set. †
26	DP: Disable Pad When set, the MAC does not automatically add padding to a frame shorter than 64 bytes. When this bit is reset, the DMA automatically adds padding and CRC to a frame shorter than 64 bytes, and the CRC field is added despite the state of the DC (TDES0[27]) bit. This is valid only when the first segment (TDES0[28]) is set. †
25	TTSE: Transmit Timestamp Enable When set, this bit enables IEEE1588 hardware timestamping for the transmit frame referenced by the descriptor. This field is valid only when the First Segment control bit (TDES0[28]) is set.
24	Reserved

Table 17–26. Transmit Descriptor Word 0 (TDES0) (Part 2 of 3)

Bit	Description
23:22	<p>CIC: Checksum Insertion Control</p> <p>These bits control the checksum calculation and insertion. The following list describes the bit encoding:</p> <ul style="list-style-type: none"> ■ 0: Checksum Insertion Disabled. ■ 1: Only IP header checksum calculation and insertion are enabled. ■ 2: IP header checksum and payload checksum calculation and insertion are enabled, but pseudoheader checksum is not calculated in hardware. ■ 3: IP Header checksum and payload checksum calculation and insertion are enabled, and pseudoheader checksum is calculated in hardware. <p>This field is valid when the First Segment control bit (TDES0[28]) is set.</p>
21	<p>TER: Transmit End of Ring</p> <p>When set, this bit indicates that the descriptor list reached its final descriptor. The DMA returns to the base address of the list, creating a descriptor ring. †</p>
20	<p>TCH: Second Address Chained</p> <p>When set, this bit indicates that the second address in the descriptor is the Next descriptor address rather than the second buffer address. When TDES0[20] is set, TBS2 (TDES1[28:16]) is a “don’t care” value. TDES0[21] takes precedence over TDES0[20]. †</p>
19:18	Reserved
17	<p>TTSS: Transmit Timestamp Status</p> <p>This field is used as a status bit to indicate that a timestamp was captured for the described transmit frame. When this bit is set, TDES2 and TDES3 have a timestamp value captured for the transmit frame. This field is only valid when the descriptor’s Last Segment control bit (TDES0[29]) is set. †</p>
16	<p>IHE: IP Header Error</p> <p>When set, this bit indicates that the MAC transmitter detected an error in the IP datagram header. The transmitter checks the header length in the IPv4 packet against the number of header bytes received from the application and indicates an error status if there is a mismatch. For IPv6 frames, a header error is reported if the main header length is not 40 bytes. Furthermore, the Ethernet Length/Type field value for an IPv4 or IPv6 frame must match the IP header version received with the packet. For IPv4 frames, an error status is also indicated if the Header Length field has a value less than 0x5. †</p>
15	<p>ES: Error Summary</p> <p>Indicates the logical OR of the following bits:</p> <ul style="list-style-type: none"> ■ TDES0[14]: Jabber Timeout ■ TDES0[13]: Frame Flush ■ TDES0[11]: Loss of Carrier ■ TDES0[10]: No Carrier ■ TDES0[9]: Late Collision ■ TDES0[8]: Excessive Collision ■ TDES0[2]: Excessive Deferral ■ TDES0[1]: Underflow Error ■ TDES0[16]: IP Header Error ■ TDES0[12]: IP Payload Error †

Table 17-26. Transmit Descriptor Word 0 (TDES0) (Part 3 of 3)

Bit	Description
14	<p>JT: Jabber Timeout</p> <p>When set, this bit indicates the MAC transmitter has experienced a jabber time-out. This bit is only set when Bit 22 (Jabber Disable) of Register 0 (MAC Configuration Register) is not set. †</p>
13	<p>FF: Frame Flushed</p> <p>When set, this bit indicates that the DMA or MTL flushed the frame because of a software Flush command given by the CPU. †</p>
12	<p>IPE: IP Payload Error</p> <p>When set, this bit indicates that MAC transmitter detected an error in the TCP, UDP, or ICMP IP datagram payload. The transmitter checks the payload length received in the IPv4 or IPv6 header against the actual number of TCP, UDP, or ICMP packet bytes received from the application and issues an error status in case of a mismatch. †</p>
11	<p>LC: Loss of Carrier</p> <p>When set, this bit indicates that a loss of carrier occurred during frame transmission (that is, the <code>gmii_crs_i</code> signal was inactive for one or more transmit clock periods during frame transmission). This is valid only for the frames transmitted without collision when the MAC operates in the half-duplex mode. †</p>
10	<p>NC: No Carrier</p> <p>When set, this bit indicates that the Carrier Sense signal from the PHY was not asserted during transmission. †</p>
9	Reserved
8	<p>EC: Excessive Collision</p> <p>When set, this bit indicates that the transmission was aborted after 16 successive collisions while attempting to transmit the current frame. If Bit 9 (Disable Retry) bit in the Register 0 (MAC Configuration Register) is set, this bit is set after the first collision, and the transmission of the frame is aborted. †</p>
7	<p>VF: VLAN Frame</p> <p>When set, this bit indicates that the transmitted frame is a VLAN-type frame. †</p>
6:3	<p>CC: Collision Count (Status field)</p> <p>These status bits indicate the number of collisions that occurred before the frame was transmitted. This count is not valid when the Excessive Collisions bit (TDES0[8]) is set. The EMAC updates this status field only in the half-duplex mode.</p>
2	<p>ED: Excessive Deferral</p> <p>When set, this bit indicates that the transmission has ended because of excessive deferral of over 24,288 bit times (155,680 bits times in 1,000-Mbps mode or if Jumbo frame is enabled) if Bit 4 (Deferral Check) bit in Register 0 (MAC Configuration Register) is set high. †</p>
1	<p>UF: Underflow Error</p> <p>When set, this bit indicates that the MAC aborted the frame because the data arrived late from the Host memory. Underflow Error indicates that the DMA encountered an empty transmit buffer while transmitting the frame. The transmission process enters the Suspended state and sets both Transmit Underflow (Register 5[5]) and Transmit Interrupt (Register 5[0]). †</p>
0	<p>DB: Deferred Bit</p> <p>When set, this bit indicates that the MAC defers before transmission because of the presence of carrier. This bit is valid only in the half-duplex mode. †</p>

Table 17-27. Transmit Descriptor Word 1 (TDES1)

Bit	Description
31:29	Reserved
28:16	TBS2: Transmit Buffer 2 Size This field indicates the second data buffer size in bytes. This field is not valid if TDES0[20] is set. For more information about calculating buffer sizes, refer to “Buffer Size Calculations” on page 17-24 . †
15:13	Reserved †
12:0	TBS1: Transmit Buffer 1 Size These bits indicate the first data buffer byte size, in bytes. If this field is 0, the DMA ignores this buffer and uses Buffer 2 or the next descriptor, depending on the value of TCH (TDES0[20]). †

Table 17-28. Transmit Descriptor 2 (TDES2)

Bit	Description
31:0	Buffer 1 Address Pointer These bits indicate the physical address of Buffer 1. There is no limitation on the buffer address alignment. For more information about buffer address alignment, refer to “Host Data Buffer Alignment” on page 17-24 . †

Table 17-29. Transmit Descriptor 3 (TDES3)

Bit	Description
31:0	Buffer 2 Address Pointer (Next Descriptor Address) Indicates the physical address of Buffer 2 when a descriptor ring structure is used. If the Second Address Chained (TDES1[24]) bit is set, this address contains the pointer to the physical memory where the Next descriptor is present. The buffer address pointer must be aligned to the bus width only when TDES1[24] is set. (LSBs are ignored internally.) †

Table 17-30. Transmit Descriptor 6 (TDES6)

Bit	Description
31:0	TTSL: Transmit Frame Timestamp Low This field is updated by DMA with the least significant 32 bits of the timestamp captured for the corresponding transmit frame. This field has the timestamp only if the Last Segment bit (LS) in the descriptor is set and Timestamp status (TTSS) bit is set. †

Table 17-31. Transmit Descriptor 7 (TDES7)

Bit	Description
31:0	TTSH: Transmit Frame Timestamp High This field is updated by DMA with the most significant 32 bits of the timestamp captured for the corresponding receive frame. This field has the timestamp only if the Last Segment bit (LS) in the descriptor is set and Timestamp status (TTSS) bit is set. †

Receive Descriptor

The structure of the received descriptor is shown in [Table 17-32](#). This can have 32 bytes of descriptor data (8 DWORDs) when advanced timestamp or IPC Full Offload feature is selected. When either of these features is enabled, the Software should set Bit 7 of Register 0 (Bus Mode Register) so that the DMA operates with extended descriptor size. When this control bit is reset, the RDES0[0] is always cleared and the RDES4-RDES7 descriptor space is not valid. †

Table 17-32. Receive Descriptor Fields - Alternate (Enhanced) Format

	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
TDES0	O W N	Status [30:0]																														
TDES1	C T R L	RES [30:29]	Buffer 2Byte Count [28:16]														Ctrl [15:14]		R E S	Buffer 1 Byte Count [12:0]												
TDES2	Buffer 1 Address [31:0]																															
TDES3	Buffer 2 Address [31:0] or Next Descriptor Address [31:0]																															
TDES4	Extended status [31:0]																															
TDES5	Reserved																															
TDES6	Transmit Timestamp Low [31:0]																															
TDES7	Transmit Timestamp High [31:0]																															

The contents of RDES0 are identified in [Table 17-33](#). The contents of RDES1 through RDES3 are identified in [Table 17-34 on page 17-56](#), [Table 17-35 on page 17-57](#), and [Table 17-36 on page 17-57](#), respectively. †

Table 17-33. Receive Descriptor Fields (RDES0)

Bit	Description
31	OWN: Own Bit When set, this bit indicates that the descriptor is owned by the DMA of the EMAC. When this bit is reset, this bit indicates that the descriptor is owned by the Host. The DMA clears this bit either when it completes the frame reception or when the buffers that are associated with this descriptor are full.
30	AFM: Destination Address Filter Fail When set, this bit indicates a frame that failed in the DA Filter in the MAC. †

Table 17-33. Receive Descriptor Fields (RDES0)

Bit	Description
29:16	<p>FL: Frame Length</p> <p>These bits indicate the byte length of the received frame that was transferred to host memory (including CRC). This field is valid when Last Descriptor (RDES0[8]) is set and either the Descriptor Error (RDES0[14]) or Overflow Error bits are reset. The frame length also includes the two bytes appended to the Ethernet frame when IP checksum calculation (Type 1) is enabled and the received frame is not a MAC control frame.</p> <p>This field is valid when Last Descriptor (RDES0[8]) is set. When the Last Descriptor and Error Summary bits are not set, this field indicates the accumulated number of bytes that have been transferred for the current frame. †</p>
15	<p>ES: Error Summary</p> <p>Indicates the logical OR of the following bits:</p> <ul style="list-style-type: none"> ■ RDES0[1]: CRC Error ■ RDES0[3]: Receive Error ■ RDES0[4]: Watchdog Timeout ■ RDES0[6]: Late Collision ■ RDES0[7]: Giant Frame ■ RDES4[4:3]: IP Header or Payload Error ■ RDES0[11]: Overflow Error ■ RDES0[14]: Descriptor Error <p>This field is valid only when the Last Descriptor (RDES0[8]) is set. †</p>
14	<p>DE: Descriptor Error</p> <p>When set, this bit indicates a frame truncation caused by a frame that does not fit within the current descriptor buffers, and that the DMA does not own the Next descriptor. The frame is truncated. This field is valid only when the Last Descriptor (RDES0[8]) is set. †</p>
13	<p>SAF: Source Address Filter Fail</p> <p>When set, this bit indicates that the SA field of frame failed the SA Filter in the MAC. †</p>
12	<p>LE: Length Error</p> <p>When set, this bit indicates that the actual length of the frame received and that the Length/ Type field does not match. This bit is valid only when the Frame Type (RDES0[5]) bit is reset. †</p>
11	<p>OE: Overflow Error</p> <p>When set, this bit indicates that the received frame was damaged because of buffer overflow in MTL.</p> <p>Note: This bit is set only when the DMA transfers a partial frame to the application. This happens only when the RX FIFO buffer is operating in the threshold mode. In the store-and-forward mode, all partial frames are dropped completely in RX FIFO buffer. †</p>
10	<p>VLAN: VLAN Tag</p> <p>When set, this bit indicates that the frame to which this descriptor is pointing is a VLAN frame tagged by the MAC. The VLAN tagging depends on checking the VLAN fields of received frame based on the Register 7 (VLAN Tag Register) setting. †</p>
9	<p>FS: First Descriptor</p> <p>When set, this bit indicates that this descriptor contains the first buffer of the frame. If the size of the first buffer is 0, the second buffer contains the beginning of the frame. If the size of the second buffer is also 0, the next descriptor contains the beginning of the frame. †</p>
8	<p>LS: Last Descriptor</p> <p>When set, this bit indicates that the buffers pointed to by this descriptor are the last buffers of the frame †</p>

Table 17-33. Receive Descriptor Fields (RDES0)

Bit	Description
7	<p>Timestamp Available, IP Checksum Error (Type1), or Giant Frame</p> <p>When advanced timestamp feature is present, when set, this bit indicates that a snapshot of the Timestamp is written in descriptor words 6 (RDES6) and 7 (RDES7). This is valid only when the Last Descriptor bit (RDES0[8]) is set.</p> <p>When IP Checksum Engine (Type 1) is selected, this bit, when set, indicates that the 16-bit IPv4 Header checksum calculated by the EMAC did not match the received checksum bytes.</p> <p>Otherwise, this bit, when set, indicates the Giant frame Status. Giant frames are larger than 1,518-byte (or 1,522-byte for VLAN or 2,000-byte when Bit 27 (2KPE) of MAC Configuration register is set) normal frames and larger than 9,018-byte (9,022-byte for VLAN) frame when Jumbo frame processing is enabled.</p>
6	<p>LC: Late Collision</p> <p>When set, this bit indicates that a late collision has occurred while receiving the frame in the half-duplex mode. †</p>
5	<p>FT: Frame Type</p> <p>When set, this bit indicates that the receive frame is an Ethernet-type frame (the LT field is greater than or equal to 0x0600). When this bit is reset, it indicates that the received frame is an IEEE802.3 frame. This bit is not valid for Runt frames less than 14 bytes.</p>
4	<p>RWT: Receive Watchdog Timeout</p> <p>When set, this bit indicates that the receive Watchdog Timer has expired while receiving the current frame and the current frame is truncated after the Watchdog Timeout. †</p>
3	<p>RE: Receive Error</p> <p>When set, this bit indicates that the <code>gmii_rxer_i</code> signal is asserted while <code>gmii_rxdv_i</code> is asserted during frame reception. Error can be of less or no extension, or error (<code>rxdr != 0xf</code>) during extension. †</p>
2	<p>DE: Dribble Bit Error</p> <p>When set, this bit indicates that the received frame has a non-integer multiple of bytes (odd nibbles). This bit is valid only in the MII Mode. †</p>
1	<p>CE: CRC Error</p> <p>When set, this bit indicates that a CRC error occurred on the received frame. This field is valid only when the Last Descriptor (RDES0[8]) is set. †</p>
0	<p>Extended Status Available/RX MAC Address</p> <p>When either advanced timestamp or IP Checksum Offload (Type 2) is present, this bit, when set, indicates that the extended status is available in descriptor word 4 (RDES4). This is valid only when the Last Descriptor bit (RDES0[8]) is set.</p> <p>When Advance Timestamp Feature or IPC Full Offload is not selected, this bit indicates RX MAC Address status. When set, this bit indicates that the RX MAC Address registers value (1 to 15) matched the frame's DA field. When reset, this bit indicates that the RX MAC Address Register 0 value matched the DA field. †</p>

Table 17-34. Receive Descriptor Fields 1 (RDES1)

Bit	Description
31	<p>DIC: Disable Interrupt on Completion</p> <p>When set, this bit prevents setting the Status Register's RI bit (CSR5[6]) for the received frame ending in the buffer indicated by this descriptor. This, in turn, disables the assertion of the interrupt to Host because of RI for that frame. †</p>
30:29	Reserved †

Table 17-34. Receive Descriptor Fields 1 (RDES1)

Bit	Description
28:16	<p>RBS2: Receive Buffer 2 Size</p> <p>These bits indicate the second data buffer size, in bytes. The buffer size must be a multiple of 4, even if the value of RDES3 (buffer2 address pointer) is not aligned to bus width. If the buffer size is not an appropriate multiple of 4, the resulting behavior is undefined. This field is not valid if RDES1[14] is set. For more information about calculating buffer sizes, refer to “Buffer Size Calculations” on page 17-24.</p>
15	<p>RER: Receive End of Ring</p> <p>When set, this bit indicates that the descriptor list reached its final descriptor. The DMA returns to the base address of the list, creating a descriptor ring. †</p>
14	<p>RCH: Second Address Chained</p> <p>When set, this bit indicates that the second address in the descriptor is the Next descriptor address rather than the second buffer address. When this bit is set, RBS2 (RDES1[28:16]) is a “don’t care” value. RDES1[15] takes precedence over RDES1[14]. †</p>
13	Reserved †
12:0	<p>RBS1: Receive Buffer 1 Size</p> <p>Indicates the first data buffer size in bytes. The buffer size must be a multiple of 4, even if the value of RDES2 (buffer1 address pointer) is not aligned. When the buffer size is not a multiple of 4, the resulting behavior is undefined. If this field is 0, the DMA ignores this buffer and uses Buffer 2 or next descriptor depending on the value of RCH (Bit 14). For more information about calculating buffer sizes, refer to “Buffer Size Calculations” on page 17-24.</p>

Table 17-35. Receive Descriptor Fields 2 (RDES2)

Bit	Description
31:0	<p>Buffer 1 Address Pointer</p> <p>These bits indicate the physical address of Buffer 1. There are no limitations on the buffer address alignment except for the following condition: The DMA uses the value programmed in RDES2[1:0] for its address generation when the RDES2 value is used to store the start of the frame. The DMA performs a write operation with the RDES2[1:0] bits as 0 during the transfer of the start of the frame but the frame is shifted as per the actual buffer address pointer. The DMA ignores RDES2[1:0] if the address pointer is to a buffer where the middle or last part of the frame is stored. For more information about buffer address alignment, refer to “Host Data Buffer Alignment” on page 17-24.</p>

Table 17-36. Receive descriptor Fields 3 (RDES3)

Bit	Description
31:0	<p>Buffer 2 Address Pointer (Next Descriptor Address)</p> <p>These bits indicate the physical address of Buffer 2 when a descriptor ring structure is used. If the Second Address Chained (RDES1[24]) bit is set, this address contains the pointer to the physical memory where the Next descriptor is present.</p> <p>If RDES1[24] is set, the buffer (Next descriptor) address pointer must be bus width-aligned (RDES3[1:0] = 0. LSBs are ignored internally.) However, when RDES1[24] is reset, there are no limitations on the RDES3 value, except for the following condition: The DMA uses the value programmed in RDES3 [1:0] for its buffer address generation when the RDES3 value is used to store the start of frame. The DMA ignores RDES3 [1:0] if the address pointer is to a buffer where the middle or last part of the frame is stored.</p>

The extended status written is as shown in Table 17-37. The extended status is written only when there is status related to IPC or timestamp available. The availability of extended status is indicated by Bit 0 of RDES0. This status is available only when the Advance Timestamp or IPC Full Offload feature is selected. †

Table 17-37. Receive Descriptor Fields 4 (RDES4) (Part 1 of 2)

Bit	Description
31:28	Reserved †
27:26	<p>Layer 3 and Layer 4 Filter Number Matched</p> <p>These bits indicate the number of the Layer 3 and Layer 4 Filter that matched the received frame.</p> <ul style="list-style-type: none"> ■ 00: Filter 0 ■ 01: Filter 1 ■ 10: Filter 2 ■ 11: Filter 3 <p>This field is valid only when Bit 24 or Bit 25 is set high. When more than one filter matches, these bits give only the lowest filter number. †</p>
25	<p>Layer 4 Filter Match</p> <p>When set, this bit indicates that the received frame matches one of the enabled Layer 4 Port Number fields. This status is given only when one of the following conditions is true:</p> <ul style="list-style-type: none"> ■ Layer 3 fields are not enabled and all enabled Layer 4 fields match. ■ All enabled Layer 3 and Layer 4 filter fields match. <p>When more than one filter matches, this bit gives the layer 4 filter status of filter indicated by Bits [27:26]. †</p>
24	<p>Layer 3 Filter Match</p> <p>When set, this bit indicates that the received frame matches one of the enabled Layer 3 IP Address fields. This status is given only when one of the following conditions is true:</p> <ul style="list-style-type: none"> ■ All enabled Layer 3 fields match and all enabled Layer 4 fields are bypassed. ■ All enabled filter fields match. <p>When more than one filter matches, this bit gives the layer 3 filter status of filter indicated by Bits [27:26]. †</p>
23:15	Reserved
14	<p>Timestamp Dropped</p> <p>When set, this bit indicates that the timestamp was captured for this frame but got dropped in the MTL RX FIFO buffer because of overflow.</p>
13	<p>PTP Version</p> <p>When set, this bit indicates that the received PTP message is having the IEEE 1588 version 2 format. When reset, it has the version 1 format.</p>
12	<p>PTP Frame Type</p> <p>When set, this bit indicates that the PTP message is sent directly over Ethernet. When this bit is not set and the message type is non-zero, it indicates that the PTP message is sent over UDP-IPv4 or UDP-IPv6. The information about IPv4 or IPv6 can be obtained from Bits 6 and 7.</p>

Table 17-37. Receive Descriptor Fields 4 (RDES4) (Part 2 of 2)

Bit	Description
11:8	<p>Message Type</p> <p>These bits are encoded to give the type of the message received.</p> <ul style="list-style-type: none"> ■ 0000: No PTP message received ■ 0001: SYNC (all clock types) ■ 0010: Follow_Up (all clock types) ■ 0011: Delay_Req (all clock types) ■ 0100: Delay_Resp (all clock types) ■ 0101: Pdelay_Req (in peer-to-peer transparent clock) ■ 0110: Pdelay_Resp (in peer-to-peer transparent clock) ■ 0111: Pdelay_Resp_Follow_Up (in peer-to-peer transparent clock) ■ 1000: Announce ■ 1001: Management ■ 1010: Signaling ■ 1011-1110: Reserved ■ 1111: PTP packet with Reserved message type
7	<p>IPv6 Packet Received</p> <p>When set, this bit indicates that the received packet is an IPv6 packet. This bit is updated only when Bit 10 (IPC) of Register 0 (MAC Configuration Register) is set.</p>
6	<p>IPv4 Packet Received</p> <p>When set, this bit indicates that the received packet is an IPv4 packet. This bit is updated only when Bit 10 (IPC) of Register 0 (MAC Configuration Register) is set.</p>
5	<p>IP Checksum Bypassed</p> <p>When set, this bit indicates that the checksum offload engine is bypassed.</p>
4	<p>IP Payload Error</p> <p>When set, this bit indicates that the 16-bit IP payload checksum (that is, the TCP, UDP, or ICMP checksum) that the EMAC calculated does not match the corresponding checksum field in the received segment. It is also set when the TCP, UDP, or ICMP segment length does not match the payload length value in the IP Header field. This bit is valid when either Bit 7 or Bit 6 is set.</p>
3	<p>IP Header Error</p> <p>When set, this bit indicates that either the 16-bit IPv4 header checksum calculated by the EMAC does not match the received checksum bytes, or the IP datagram version is not consistent with the Ethernet Type value. This bit is valid when either Bit 7 or Bit 6 is set.</p>
2:0	<p>IP Payload Type</p> <p>These bits indicate the type of payload encapsulated in the IP datagram processed by the receive Checksum Offload Engine (COE). The COE also sets these bits to 0 if it does not process the IP datagram's payload due to an IP header error or fragmented IP.</p> <ul style="list-style-type: none"> ■ 0: Unknown or did not process IP payload ■ 1: UDP ■ 2: TCP ■ 3: ICMP ■ 4-7: Reserved <p>This bit is valid when either Bit 7 or Bit 6 is set.</p>

RDES6 and RDES7 contain the snapshot of the timestamp. The availability of the snapshot of the timestamp in RDES6 and RDES7 is indicated by Bit 7 in the RDES0 descriptor. The contents of RDES6 and RDES7 are identified in [Table 17-38](#) and [Table 17-39 on page 17-60](#), respectively. †

Table 17-38. Receive Descriptor Fields 6 (RDES6)

Bit	Description
31:0	RTSL: Receive Frame Timestamp Low This field is updated by DMA with the least significant 32 bits of the timestamp captured for the corresponding receive frame. This field is updated by DMA only for the last descriptor of the receive frame which is indicated by Last Descriptor status bit (RDES0[8]). †

Table 17-39. Receive Descriptor Fields 7 (RDES7)

Bit	Description
31:0	RTSH: Receive Frame Timestamp High This field is updated by DMA with the most significant 32 bits of the timestamp captured for the corresponding receive frame. This field is updated by DMA only for the last descriptor of the receive frame which is indicated by Last Descriptor status bit (RDES0[8]). †

Initializing DMA



This section provides the instructions for initializing the DMA/MAC registers in the proper sequence. Perform the following steps to initialize the DMA:

1. Provide a software reset. This resets all of the EMAC internal registers and logic. (DMA Register 0 (Bus Mode Register) – bit 0). †
2. Wait for the completion of the reset process (poll bit 0 of the DMA Register 0 (Bus Mode Register), which is only cleared after the reset operation is completed). †
3. Poll the bits of Register 11 (AHB or AXI Status) to confirm that all previously initiated (before software-reset) or ongoing transactions are complete.



If the application cannot poll the register after soft reset (because of performance reasons), then it is recommended that you continue with the next steps and check this register again (as mentioned in [step 12](#)) before triggering the DMA operations. †

4. Program the following fields to initialize the Bus Mode Register by setting values in DMA Register 0 (Bus Mode Register): †
 - a. Mixed Burst and AAL
 - b. Fixed burst or undefined burst †
 - c. Burst length values and burst mode values. †
 - d. Descriptor Length (only valid if Ring Mode is used) †
 - e. TX and RX DMA Arbitration scheme †
5. Program the interface options in Register 10 (AXI Bus Mode Register). If fixed burst-length is enabled, then select the maximum burst-length possible on the bus (bits[7:1]). †

6. Create a proper descriptor chain for transmit and receive. In addition, ensure that the receive descriptors are owned by DMA (bit 31 of descriptor should be set). When OSF mode is used, at least two descriptors are required. For more information about descriptors, refer to “Normal Descriptor” on page 17-36 and “Alternate or Enhanced Descriptors” on page 17-47. †
 7. Make sure that your software creates three or more different transmit or receive descriptors in the chain before reusing any of the descriptors. †
 8. Initialize receive and transmit descriptor list address with the base address of the transmit and receive descriptor (Register 3 (Receive Descriptor List Address Register) and Register 4 (Transmit Descriptor List Address Register) respectively). †
 9. Program the following fields to initialize the mode of operation in Register 6 (Operation Mode Register)
 - a. Receive and Transmit Store And Forward †
 - b. Receive and Transmit Threshold Control (RTC and TTC) †
 - c. Hardware Flow Control enable †
 - d. Flow Control Activation and De-activation thresholds for MTL Receive and Transmit FIFO buffers (RFA and RFD) †
 - e. Error frame and undersized good frame forwarding enable †
 - f. OSF Mode †
 10. Clear the interrupt requests, by writing to those bits of the status register (interrupt bits only) that are set. For example, by writing 1 into bit 16, the normal interrupt summary clears this bit (DMA Register 5 (Status Register)). †
 11. Enable the interrupts by programming the Register 7 (Interrupt Enable Register). †
-  Perform step 12 only if you did not perform step 3. †
12. Read Register 11 (AHB or AXI Status) to confirm that all previous transactions are complete. †
-  If any previous transaction is still in progress when you read the Register 11 (AHB or AXI Status), then it is strongly recommended to check the slave components addressed by the master interface.
13. Start the receive and transmit DMA by setting SR (bit 1) and ST (bit 13) of the control register (DMA Register 6 (Operation Mode Register)). †

Initializing MAC

The following MAC Initialization operations can be performed after DMA initialization. If the MAC initialization is done before the DMA is set-up, then enable the MAC receiver (last step below) only after the DMA is active. Otherwise, received frames fills the RX FIFO buffer and overflow. †

1. Program the EMAC Register 4 (GMII Address Register) for controlling the management cycles for external PHY. For example, Physical Layer Address PA (bits 15-11). In addition, set bit 0 (GMII Busy) for writing into PHY and reading from PHY. †
2. Read the 16-bit data of Register 5 (GMII Data Register) from the PHY for link up, speed of operation, and mode of operation, by specifying the appropriate address value in bits 15-11 of Register 4 (GMII Address Register). †
3. Provide the MAC address registers (Register 16 (MAC Address0 High Register) and Register 17 (MAC Address0 Low Register)). Because 128 MAC addresses are supported, you need to program the MAC addresses accordingly.
4. Program Register 2 (Hash Table High Register) and Register 3 (Hash Table Low Register).
5. Program the following fields to set the appropriate filters for the incoming frames in Register 1 (MAC Frame Filter): †
 - a. Receive All †
 - b. Promiscuous mode †
 - c. Hash or Perfect Filter †
 - d. Unicast, multicast, broadcast, and control frames filter settings †
6. Program the following fields for proper flow control in Register 6 (Flow Control Register): †
 - a. Pause time and other pause frame control bits †
 - b. Receive and Transmit Flow control bits †
 - c. Flow Control Busy/Backpressure Activate †
7. Program the Interrupt Mask register bits, as required, and if applicable, for your configuration. †
8. Program the appropriate fields in Register 0 (MAC Configuration Register). For example, Interframe gap while transmission and jabber disable. Based on the Auto-negotiation you can set the Duplex mode (bit 11) or port select (bit 15). †
9. Set Bit 3 (TE) and Bit 2 (RE) in Register 0 (MAC Configuration Register). †



Do not change the configuration (such as duplex mode, speed, port, or loopback) when the EMAC DMA is actively transmitting or receiving. The Software should change these parameters only when the EMAC DMA transmitter and receiver are not active.

Performing Normal Receive and Transmit Operation

For normal operation, perform the following steps: †

1. For normal transmit and receive interrupts, read the interrupt status. Then, poll the descriptors, reading the status of the descriptor owned by the Host (either transmit or receive). †

2. Set appropriate values for the descriptors, ensuring that transmit and receive descriptors are owned by the DMA to resume the transmission and reception of data. †
3. If the descriptors are not owned by the DMA (or no descriptor is available), the DMA goes into SUSPEND state. The transmission or reception can be resumed by freeing the descriptors and issuing a poll demand by writing 0 into the TX/RX poll demand register (Register 1 (Transmit Poll Demand Register) and Register 2 (Receive Poll Demand Register)). †
4. The values of the current host transmitter or receiver descriptor address pointer can be read for the debug process (Register 18 (Current Host Transmit Descriptor Register) and Register 19 (Current Host Receive Descriptor Register)). †
5. The values of the current host transmit buffer address pointer and receive buffer address pointer can be read for the debug process (Register 20 (Current Host Transmit Buffer Address Register) and Register 21 (Current Host Receive Buffer Address Register)). †

Stopping and Starting Transmission

Perform the following steps to pause the transmission for some time: †

1. Disable the transmit DMA (if applicable), by clearing bit 13 (Start or Stop Transmission Command) of Register 6 (Operation Mode Register). †
2. Wait for any previous frame transmissions to complete. You can check this by reading the appropriate bits of Register 9 (Debug Register). †
3. Disable the MAC transmitter and MAC receiver by clearing Bit 3 (TE) and Bit 2 (RE) in Register 0 (MAC Configuration Register). †
4. Disable the receive DMA (if applicable), after making sure that the data in the RX FIFO buffer is transferred to the system memory (by reading Register 9 (Debug Register)). †
5. Make sure that both TX FIFO buffer and RX FIFO buffer are empty. †
6. To re-start the operation, first start the DMAs, and then enable the MAC transmitter and receiver. †


Programming Guidelines for Energy Efficient Ethernet


Entering and Exiting the TX LPI Mode


The Energy Efficient Ethernet (EEE) feature is available in the EMAC. To use it, perform the following steps during EMAC initialization:

1. Read the PHY register through the MDIO interface, check if the remote end has the EEE capability, and then negotiate the timer values. †
2. Program the PHY registers through the MDIO interface (including the RX_CLK_stoppable bit that indicates to the PHY whether to stop RX clock in LPI mode.) †
3. Program Bits[16:5], LST, and Bits[15:0], TWT, in Register 13 (LPI Timers Control Register). †

4. Read the link status of the PHY chip by using the MDIO interface and update Bit 17 (PLS) of Register 12 (LPI Control and Status Register) accordingly. This update should be done whenever the link status in the PHY chip changes. †
5. Set Bit 16 (LPIEN) of Register 12 (LPI Control and Status Register) to make the MAC enter the LPI state. The MAC enters the LPI mode after completing the transmission in progress and sets Bit 0 (TLPIEN). †

 To make the MAC enter the LPI state only after it completes the transmission of all queued frames in the TX FIFO buffer, you should set Bit 19 (LPITXA) in Register 12 (LPI Control and Status Register). †

 To switch off the transmit clock during the LPI state, use the `sbd_tx_clk_gating_ctrl_o` signal for gating the clock input. †

 To switch off the CSR clock or power to the rest of the system during the LPI state, you should wait for the TLPIEN interrupt of Register 12 (LPI Control and Status Register) to be generated. Restore the clocks before performing the step 6 when you want to come out of the LPI state. †

6. Reset Bit 16 (LPIEN) of Register 12 (LPI Control and Status Register) to bring the MAC out of the LPI state. †

The MAC waits for the time programmed in Bits [15:0], TWT, before setting the TLPIEX interrupt status bit and resuming the transmission. †

Gating Off the CSR Clock in the LPI Mode

You can gate off the CSR clock to save the power when the MAC is in the Low-Power Idle (LPI) mode. †

Gating Off the CSR Clock in the RX LPI Mode

The following operations are performed when the MAC receives the LPI pattern from the PHY. †

1. The MAC RX enters the LPI mode and the RX LPI entry interrupt status [RLPIEN interrupt of Register 12 (LPI_Control_Status)] is set. †
2. The interrupt pin (`sbd_intr_o`) is asserted. The `sbd_intr_o` interrupt is cleared when the host reads the Register 12 (LPI_Control_Status). †

After the `sbd_intr_o` interrupt is asserted and the MAC TX is also in the LPI mode, you can gate-off the CSR clock. If the MAC TX is not in the LPI mode when you gate off the CSR clock, the events on the MAC transmitter do not get reported or updated in the CSR. †

For restoring the CSR clock, wait for the LPI exit indication from the PHY after which the MAC asserts the LPI exit interrupt on `lpi_intr_o` (synchronous to `clk_rx_i`). The `lpi_intr_o` interrupt is cleared when Register 12 is read. †

Gating Off the CSR Clock in the TX LPI Mode

The following operations are performed when Bit 16 (LPIEN) of Register 12 (LPI Control and Status Register) is set: †

1. The Transmit LPI Entry interrupt (TLPIEN bit of Register 12) is set. †

2. The interrupt pin (`sbd_intr_o`) is asserted. The `sbd_intr_o` interrupt is cleared when the host reads the Register 12. †

After the `sbd_intr_o` interrupt is asserted and the MAC RX is also in the LPI mode, you can gate off the CSR clock. If the MAC RX is not in the LPI mode when you gate off the CSR clock, the events on the MAC receiver do not get reported or updated in the CSR. †

For restoring the CSR clock, switch on the CSR clock when the MAC has to come out of the TX LPI mode. †

After the CSR clock is resumed, reset Bit 16 (LPIEN) of Register 12 (LPI Control and Status Register) to bring the MAC out of the LPI mode. †

Programming Guidelines for Flexible Pulse-Per-Second (PPS) Output

Generating Single Pulse on PPS

To generate single Pulse on PPS: †

1. Program 11 or 10 (for interrupt) in Bits [6:5], `TRGTMODESEL`, of Register 459 (PPS Control Register). This instructs the MAC to use the Target Time registers (register 455 and 456) for start time of PPS signal output. †
2. Program the start time value in the Target Time registers (register 455 and 456). †
3. Program the width of the PPS signal output in Register 473 (PPS0 Width Register). †
4. Program Bits [3:0], `PPSCMD`, of Register 459 (PPS Control Register) to 0001. This instructs the MAC to generate single pulse on the PPS signal output at the time programmed in the Target Time registers (register 455 and 456). †

Once the `PPSCMD` is executed (`PPSCMD` bits = 0), you can cancel the pulse generation by giving the Cancel Start Command (`PPSCMD`=0011) before the programmed start time elapses. You can also program the behavior of the next pulse in advance. To program the next pulse: †

1. Program the start time for the next pulse in the Target Time registers (register 455 and 456). This time should be more than the time at which the falling edge occurs for the previous pulse. †
2. Program the width of the next PPS signal output in Register 473 (PPS0 Width Register). †
3. Program Bits [3:0], `PPSCMD`, of Register 459 (PPS Control Register) to generate a single pulse after the time at which the previous pulse is de-asserted. This instructs the MAC to generate single pulse on the PPS signal output, at the time programmed in Target Time registers. If you give this command before the previous pulse becomes low, then the new command overwrites the previous command and the EMAC may generate only 1 extended pulse.

Generating a Pulse Train on PPS

To generate a pulse train on PPS: †

1. Program 11 or 10 (for interrupt) in Bits [6:5], TRGTMODSEL, of Register 459 (PPS Control Register). This instructs the MAC to use the Target Time registers (register 455 and 456) for start time of the PPS signal output. †
2. Program the start time value in the Target Time registers (register 455 and 456). †
3. Program the interval value between the train of pulses on the PPS signal output in Register 473 (PPS0 Width Register). †
4. Program the width of the PPS signal output in Register 473 (PPS0 Width Register). †
5. Program Bits[3:0], PPSCMD, of Register 459 (PPS Control Register) to 0010. This instructs the MAC to generate train of pulses on the PPS signal output with start time programmed in Target Time registers (register 455 and 456). By default, the PPS pulse train is free-running unless stopped by 'STOP Pulse train at time' or 'STOP Pulse Train immediately' commands. †
6. Program the stop value in the Target Time registers (register 455 and 456). Ensure that Bit 31 (TSTRBUSY) of Register 456 (Target Time Nanoseconds Register) is reset before programming the Target Time registers (register 455 and 456) again. †
7. Program the PPSCMD field (bit 3:0) of Register 459 (PPS Control Register) to 0100. This stops the train of pulses on PPS signal output after the programmed stop time specified in Step 6 elapses. †

You can stop the pulse train at any time by programming 0101 in the PPSCMD field. Similarly, you can cancel the Stop Pulse train command (given in step 7) by programming 0110 in the PPSCMD field before the time (programmed in step 6) elapses. You can cancel the pulse train generation by programming 0011 in the PPSCMD field before the programmed start time (in step 2) elapses. †

Generating an Interrupt without Affecting the PPS


The Bits [6:5], TRGTMODSEL, of the Register 459 (PPS Control Register) enable you to program the Target Time registers (register 455 and 456) to do any one of the following: †

- Generate only interrupts. †
- Generate interrupts and the PPS start and stop time. †
- Generate only PPS start and stop time. †

To program the Target Time registers (register 455 and 456) to generate only interrupt event: †

1. Program 00 (for interrupt) in Bits [6:5], TRGTMODSEL, of Register 459 (PPS Control Register). This instructs the MAC to use the Target Time registers (register 455 and 456) for target time interrupt. †
2. Program a target time value in the Target Time registers (register 455 and 456). This instructs the MAC to generate an interrupt when the target time elapses. If Bits [6:5], TRGTMODSEL, are changed (for example, to control the PPS), then the interrupt generation is over-written with the new mode and new programmed Target Time register value.


Ethernet MAC Address Map and Register Definitions

 The address map and register definitions reside in the [hps.html](#) file that accompanies this handbook volume. Click the link to open the file.

To view the module description and base address, scroll to and click the link for either of the following module instances:

- **emac0**
- **emac1**

To then view the register and field descriptions, scroll to and click the register names. The register addresses are offsets relative to the base address of each module instance.

 The base addresses of all modules are also listed in the *Introduction to the Hard Processor System* chapter in volume 3 of the *Cyclone V Device Handbook*.

Document Revision History

Table 17-40 shows the revision history for this document.

Table 17-40. Document Revision History

Date	Version	Changes
November 2012	1.2	Minor updates.
May 2012	1.1	Added programming model section.
January 2012	1.0	Initial release.

The hard processor system (HPS) provides two instances of a USB On-The-Go (OTG) controller that supports both device and host functions. The controller supports all high-speed, full-speed, and low-speed transfers in both device and host modes. The controller is fully compliant with the *On-The-Go and Embedded Host Supplement to the USB Revision 2.0 Specification*. The controller can be programmed for both device and host functions to support data movement over the USB protocol.

The controllers are operationally independent of each other. Each USB OTG controller supports a single USB port connected through a USB 2.0 Transceiver Macrocell Interface Plus (UTMI+) Low Pin Interface (ULPI) compliant PHY. The USB OTG controllers are instances of the Synopsys® DesignWare® Cores USB 2.0 Hi-Speed On-The-Go (DWC_otg) controller.

The USB OTG controller is optimized for the following applications and systems: †

- Portable electronic devices †
- Point-to-point applications (no hub, direct connection to HS, FS, or LS device) †
- Multi-point applications (as an embedded USB host) to devices (hub and split support) †

Each of the two USB OTG ports supports both host and device modes, as described in the *On-The-Go and Embedded Host Supplement to the USB Revision 2.0 Specification*. The USB OTG ports support connections for all types of USB peripherals, including the following peripherals:

- Mouse
- Keyboard
- Digital cameras
- Network adapters
- Hard drives
- Generic hubs



Additional information is available in the *On-The-Go and Embedded Host Supplement to the USB Revision 2.0 Specification*, which you can download from the USB Implementers Forum website (www.usb.org).

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†Paragraphs marked with the dagger (†) symbol are Synopsys Proprietary. Used with permission.



Features of the USB OTG Controller

The USB OTG controller has the following USB-specific features:

- Complies with both Revision 1.3 and Revision 2.0 of the *On-The-Go and Embedded Host Supplement to the USB Revision 2.0 Specification*
- Supports software-configurable modes of operation between OTG 1.3 and OTG 2.0
- Supports all USB 2.0 speeds:
 - High speed (HS, 480-Mbps)
 - Full speed (FS, 12-Mbps)
 - Low speed (LS, 1.5-Mbps)



In host mode, all speeds are supported. However, in device mode, only high speed and full speed are supported.

- Supports all USB transaction types:
 - Control transfers
 - Bulk transfers
 - Isochronous transfers
 - Interrupts
- Supports automatic ping capability
- Supports Session Request Protocol (SRP) and Host Negotiation Protocol (HNP)
- Supports suspend, resume, and remote wake
- Supports up to 16 host channels



In host mode, when the number of device endpoints is greater than the number of host channels, software can reprogram the channels to support up to 127 devices, each having 32 endpoints (IN + OUT), for a maximum of 4,064 endpoints.

- Supports up to 16 bidirectional endpoints, including control endpoint 0



Only seven periodic device IN endpoints are supported.

- Supports a generic root hub
- Performs transaction scheduling in hardware

On the USB PHY layer, the USB OTG controller supports the following features:

- A single USB port connected to each OTG instance
- A ULPI connection to an off-chip USB transceiver

- Software-controlled access, supporting vendor-specific or optional PHY registers access to ease debug
- The OTG 2.0 support for Attach Detection Protocol (ADP) only through an external (off-chip) ADP controller

On the integration side, the USB OTG controller supports the following features:

- Different clocks for system and PHY interfaces
- Dedicated TX FIFO buffer for each device IN endpoint in direct memory access (DMA) mode
- Packet-based, dynamic FIFO memory allocation for endpoints for small FIFO buffers and flexible, efficient use of RAM that can be dynamically sized by software
- Ability to change an endpoint's FIFO memory size during transfers
- Clock gating support during USB suspend and session-off modes
 - PHY clock gating support
 - System clock gating support
- Data FIFO RAM clock gating support



The USB OTG controller does not support the following protocols:

- Enhanced Host Controller Interface (EHCI)
- Open Host Controller Interface (OHCI)
- Universal Host Controller Interface (UHCI)

Supported PHYs

Table 18–1 lists some PHYs that are compatible with the USB OTG.

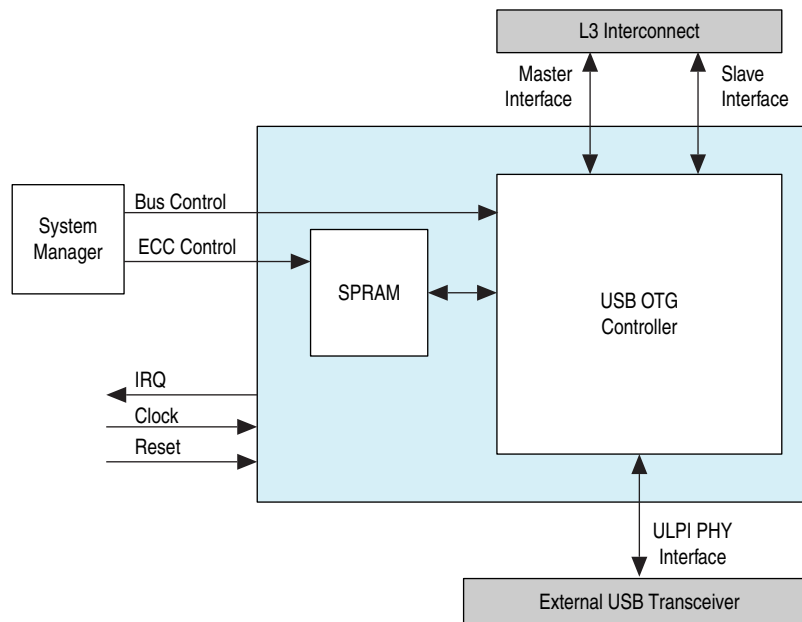
Table 18–1. Supported PHYs

Manufacturer	Part Number
TI	TUSB1210
NXP	ISP1504
Cypress	CY7C68003
SMSC	USB3300

USB OTG Controller Block Diagram and System Integration

Figure 18-1 is a block diagram showing one USB OTG controller subsystem in the HPS. Two subsystems are included in the HPS.

Figure 18-1. USB OTG Controller System Integration



The USB OTG controller connects to the level 3 (L3) interconnect through a slave interface, allowing other masters to access the control and status registers (CSRs) in the controller. The controller also connects to the L3 interconnect through a master interface, allowing the DMA engine in the controller to move data between external memory and the controller.

A single-port RAM (SPRAM) connected to the USB OTG controller is used to store USB data packets for both host and device modes. It is configured as FIFO buffers for receive and transmit data packets on the USB link.

Through the system manager, the USB OTG controller has control to use and test error correction codes (ECCs) in the SPRAM. Through the system manager, the USB OTG controller can also control the behavior of the master interface to the L3 interconnect.



For more information, refer to the *System Manager* chapter in volume 3 of the *Cyclone V Device Handbook*.

The USB OTG controller connects to the external USB transceiver through a ULPI PHY interface. This interface also connects through pin multiplexers within the HPS. The pin multiplexers are controlled by the system manager.

Additional connections on the USB OTG controller include:

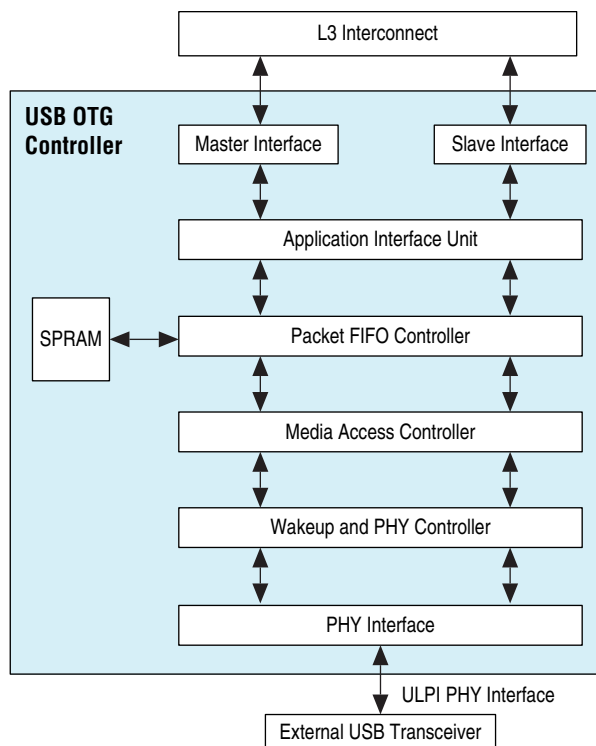
- Clock input from the clock manager to the USB OTG controller
- Reset input from the reset manager to the USB OTG controller
- Interrupt line from the USB OTG controller to the microprocessor unit (MPU) global interrupt controller (GIC).

Functional Description of the USB OTG Controller

USB OTG Controller Block Description

Figure 18-2 is a block diagram of the USB OTG controller. The following sections provide detail about each of the units that comprise the USB OTG controller.

Figure 18-2. USB OTG Controller Block Diagram



Master Interface

The master interface includes a built-in DMA controller. The DMA controller moves data between external memory and the media access controller (MAC).

Properties of the master interface are controlled through the USB L3 Master HPROT Register (`l3master`) in the system manager. These bits provide access information to the L3 interconnect, including whether or not transactions are cacheable, bufferable, or privileged.



Bits in the `l3master` register can be updated only when the master interface is guaranteed to be in an inactive state.

Slave Interface

The slave interface allows other masters in the system to access the USB OTG controller's CSRs. For testing purposes, other masters can also access the SPRAM.

Slave Interface CSR Unit

The slave interface can read from and write to all the CSRs in the USB OTG controllers. All register accesses are 32 bits.

The CSR is divided into the following groups of registers:

- Global
- Host
- Device
- Power and clock gating

Some registers are shared between host and device modes, because the controller can only be in one mode at a time. The controller generates a mode mismatch interrupt if a master attempts to access device registers when the controller is in host mode, or attempts to access host registers when the controller is in device mode. Writing to unimplemented registers is ignored. Reading from unimplemented registers returns indeterminate values.

Application Interface Unit

The application interface unit (AIU) generates DMA requests based on programmable FIFO buffer thresholds. The AIU generates interrupts to the GIC for both host and device modes. A DMA scheduler is included in the AIU to arbitrate and control the data transfer between packets in system memory and their respective USB endpoints.

Packet FIFO Controller

The Packet FIFO Controller (PFC) connects the AIU with the MAC through data FIFO buffers located in the SPRAM. In device mode, one FIFO buffer is implemented for each IN endpoint. In host mode, a single FIFO buffer stores data for all periodic (isochronous and interrupt) OUT endpoints, and a single FIFO buffer is used for nonperiodic (control and bulk) OUT endpoints. Host and device mode share a single receive data FIFO buffer.

SPRAM

An SPRAM implements the data FIFO buffers for host and device modes. The size of the FIFO buffers can be programmed dynamically.

The SPRAM supports ECCs. ECCs can be enabled through the system manager, by setting the RAM ECC Enable (en) bit in the USB0 or USB1 RAM ECC Enable Register (usb0 or usb1), in the ECC Management Register Group (eccgrp). Single-bit and double-bit errors in each USB instance can be injected using this register.

The SPRAM provides outputs to notify the system manager when single-bit correctable errors are detected (and corrected), and when double-bit (uncorrectable) errors are detected. The system manager generates an interrupt to the GIC when an ECC error is detected.

MAC

The MAC module implements the following functionality:

- USB transaction support
- Host protocol support
- Device protocol support
- OTG protocol support
- Link power management (LPM) functions

USB Transactions

In device mode, the MAC decodes and checks the integrity of all token packets. For valid OUT or SETUP tokens, the following DATA packet is also checked. If the data packet is valid, the MAC performs the following steps:

1. Writes the data to the receive FIFO buffer
2. Sends the appropriate handshake when required to the USB host.

If a receive FIFO buffer is not available, the MAC sends a NAK response to the host. The MAC also supports ping protocol.

For IN tokens, if data is available in the transmit FIFO buffer, the MAC performs the following steps:

1. Reads the data from the FIFO buffer
2. Forms the data packet
3. Transmits the packet to the host
4. Receives the response from the host
5. Sends the updated status to the PFC

In host mode, the MAC receives a token request from the AIU. The MAC performs the following steps:

1. Builds the token packet
2. Sends the packet to the device

For OUT or SETUP transactions, the MAC also performs the following steps:

1. Reads the data from the transmit FIFO buffer
2. Assembles the data packet
3. Sends the packet to the device
4. Waits for a response

The response from the device causes the MAC to send a status update to the AIU.

For IN or PING transactions, the MAC waits for the data or handshake response from the device. For data responses, the MAC performs the following steps:

1. Validates the data
2. Writes the data to the receive FIFO buffer

3. Sends a status update to the AIU
4. Sends a handshake to the device, if appropriate

Host Protocol

In host mode, the MAC performs the following functions:

- Detects connect, disconnect, and remote wakeup events on the USB link
- Initiates reset
- Initiates speed enumeration processes
- Generates Start of Frame (SOF) packets.

Device Protocol

In device mode, the MAC performs the following functions:

- Handles USB reset sequence
- Handles speed enumeration
- Detects USB suspend and resume activity on the USB link
- Initiates remote wakeup
- Decodes SOF packets

OTG Protocol

The MAC handles HNP and SRP for OTG operation. HNP provides a mechanism for swapping host and device roles. SRP provides mechanisms for the host to turn off V_{BUS} to save power, and for a device to request a new USB session.

LPM Functions

The USB OTG controller supports LPM in both host and device modes. With this feature, the USB OTG controller can enter a sleep state when a successful LPM transaction occurs on the USB link.

Wakeup and Power Control

To reduce power, the USB OTG controller supports a power-down mode. In power-down mode, the controller and the PHY can shut down their clocks. The controller supports wakeup on the detection of the following events:

- Resume
- Remote wakeup
- Session request protocol
- New session start

PHY Interface Unit

The USB OTG controller supports synchronous SDR data transmission to a ULPI PHY. The SDR mode implements an eight-bit data bus.

ULPI PHY Interface

The ULPI PHY interface is synchronous to the `ulpi_clk` signal coming from the PHY. Table 18-2 lists the ULPI PHY interface names and related information.

Table 18-2. ULPI PHY Interfaces

Port Name	Bit Width	Direction	Description
<code>ulpi_clk</code>	1	Input	ULPI Clock Receives the 60-MHz clock supplied by the high-speed ULPI PHY. All signals are synchronous to the positive edge of the clock.
<code>ulpi_dir</code>	1	Input	ULPI Data Bus Control 1—The PHY has data to transfer to the USB OTG controller. 0—The PHY does not have data to transfer.
<code>ulpi_nxt</code>	1	Input	ULPI Next Data Control Indicates that the PHY has accepted the current byte from the USB OTG controller. When the PHY is transmitting, this signal indicates that a new byte is available for the controller.
<code>ulpi_stp</code>	1	Output	ULPI Stop Data Control The controller drives this signal high to indicate the end of its data stream. The controller can also drive this signal high to request data from the PHY.
<code>ulpi_data[7:0]</code>	8	Bidirectional	Bidirectional data bus. Driven low by the controller during idle.

Clocks

All clocks must be operational when reset is released. No special handling is required on the clocks.

Table 18-3 lists the USB OTG controller clock inputs.

Table 18-3. USB OTG Controller Clock Inputs

Clock Signal	Frequency	Functional Usage
<code>usb_mp_clk</code>	60 – 200 MHz	Drives the master and slave interfaces, DMA controller, and internal FIFO buffers
<code>usb0_ulpi_clk</code>	60 MHz	ULPI reference clock for usb0 from external ULPI PHY I/O pin
<code>usb1_ulpi_clk</code>	60 MHz	ULPI reference clock for usb1 from external ULPI PHY I/O pin

Resets

The USB OTG controller can be reset either through the hardware reset input or through software.

Reset Requirements

There must be a minimum of 12 cycles on the `ulpi_clk` clock before the controller is taken out of reset. During reset, the USB OTG controller asserts the `ulpi_stp` signal. The PHY outputs a clock when it sees the `ulpi_stp` signal asserted. However, if the pin multiplexers are not programmed, the PHY does not see the `ulpi_stp` signal. As a result, the `ulpi_clk` clock signal does not arrive at the USB OTG controller.

Software must ensure that the reset is active for a minimum of two `usb_mp_clk` cycles. There is no maximum assertion time.

Hardware Reset

Each of the USB OTG controllers has one reset input from the reset manager. The reset signal is asserted during a cold or warm reset event. The reset manager holds the controllers in reset until software releases the resets. Software releases resets by clearing the appropriate USB bits in the Peripheral Module Reset Register (`permodrst`) in the HPS reset manager.

The reset input resets the following blocks:

- The master and slave interface logic
- The integrated DMA controller
- The internal FIFO buffers
- The CSR

The reset input is synchronized to the `usb_mp_clk` domain. The reset input is also synchronized to the ULPI clock within the USB OTG controller and is used to reset the ULPI PHY domain logic.

Software Reset

Software can reset the controller by setting the Core Soft Reset (`csftrst`) bit in the Reset Register (`grstctl`) in the Global Registers (`globgrp`) group of the USB OTG controller.

Software resets are useful in the following situations:

- A PHY selection bit is changed by software. Resetting the USB OTG controller is part of clean-up to ensure that the PHY can operate with the new configuration or clock.
- During software development and debugging.

Interrupts

Each USB OTG controller has a single interrupt output. Interrupts are asserted on the conditions shown in [Table 18-4](#).

Table 18-4. USB OTG Interrupt Conditions

Condition	Mode
Device-initiated remote wakeup is detected.	Host mode
Session request is detected from the device.	Host mode
Device disconnect is detected.	Host mode
Host LPM entry retry has expired or LPM transaction(s) are complete.	Host mode
Host periodic TX FIFO buffer is empty (can be further programmed to indicate half-empty).	Host mode
Host channels interrupt received.	Host mode
Incomplete periodic transfer is pending at the end of the microframe.	Host mode
Host port status interrupt received.	Host mode
External host initiated resume is detected.	Device mode
LPM handshake is sent.	Device mode
Reset is detected when in suspend or normal mode.	Device mode
USB suspend mode is detected.	Device mode
Data fetch is suspended due to TX FIFO buffer full or request queue full.	Device mode
At least one isochronous OUT endpoint is pending at the end of the microframe.	Device mode
At least one isochronous IN endpoint is pending at the end of the microframe.	Device mode
At least one IN or OUT endpoint interrupt is pending at the end of the microframe.	Device mode
The end of the periodic frame is reached.	Device mode
Failure to write an isochronous OUT packet to the RX FIFO buffer. The RX FIFO buffer does not have enough space to accommodate the maximum packet size for the isochronous OUT endpoint.	Device mode
Enumeration has completed.	Device mode
Connector ID change.	Common modes
Mode mismatch. Software accesses registers belonging to an incorrect mode.	Common modes
Nonperiodic TX FIFO buffer is empty.	Common modes
RX FIFO buffer is not empty.	Common modes
Start of microframe.	Common modes
Device connection debounce is complete in host mode.	OTG interrupts
A-Device timeout while waiting for B-Device connection.	OTG interrupts
Host negotiation is complete.	OTG interrupts
Session request is complete.	OTG interrupts
Session end is detected in device mode.	OTG interrupts

USB OTG Controller Programming Model

For detailed information about using the USB OTG controller, consult your operating system (OS) driver documentation. The OS vendor provides application programming interfaces (APIs) to control USB host, device and OTG operation. This section provides a brief overview of the following software operations:

- Enabling SPRAM ECCs
- Host operation
- Device operation

Enabling SPRAM ECCs

To avoid false ECC errors, you must initialize the ECC bits in the SPRAM before using ECCs. To initialize the ECC bits, software writes data to all locations in the SPRAM.

The L3 interconnect has access to the SPRAM is accessible through the USB OTG L3 slave interface. Software accesses the SPRAM through the `directfifo` memory space, in the USB OTG controller address space.

The SPRAM contains 8192 (32 KB) locations. The L3 slave provides 32-bit access to the SPRAM. Physically the SPRAM is implemented as a 35-bit memory, with the highest three bits reserved for the USB OTG controller's internal use. When a write is performed to the SPRAM through the L3 slave interface, bits 32 through 34 of the internal data bus are tied to 1, to enable the ECC bits to be initialized.

The `directfifo` memory space is described in the controller address map. Refer to [“USB OTG Controller Address Map and Register Definitions” on page 18–15](#).



Software cannot access the SPRAM beyond the 32-KB range. Out-of-range read transactions return indeterminate data. Out-of-range write transactions are ignored.

Host Operation

Host Initialization

After power up, the USB port is in its default mode. No V_{BUS} is applied to the USB cable. The following process sets up the USB OTG controller as a USB host.

1. To enable power to the USB port, the software driver sets the Port Power (`prtpwr`) bit to 1 in the Host Port Control and Status Register (`hprt`) of the Host Mode Registers (`hostgrp`) group. This action drives the V_{BUS} signal on the USB link.
The controller waits for a connection to be detected on the USB link.
2. When a USB device connects, an interrupt is generated. The Port Connect Detected (`PrtConnDet`) bit in `hprt` is set to 1.
3. Upon detecting a port connection, the software driver initiates a port reset by setting the Port Reset (`prtrst`) bit to 1 in `hprt`.
4. The software driver must wait a minimum of 10 ms so that speed enumeration can complete on the USB link.
5. After the 10 ms, the software driver sets `prtrst` back to 0 to release the port reset.

6. The USB OTG controller generates an interrupt. The Port Enable Disable Change (`prtENCHng`) and Port Speed (`prtSPD`) bits, in `hprt`, are set to reflect the enumerated speed of the device that attached.

At this point the port is enabled for communication. Keep alive or SOF packets are sent on the port. If a USB 2.0-capable device fails to initialize correctly, it is reported as a USB 1.1 device.

The Host Frame Interval Register (`hfir`) is updated with the corresponding PHY clock settings. The `hfir`, used for sending SOF packets, is in the Host Mode Registers (`hostgrp`) group.

7. The software driver must program the following registers in the Global Registers (`globgrp`) group, in the order listed:
 - a. Receive FIFO Size Register (`grxfSiz`)—selects the size of the receive FIFO buffer
 - b. Non-periodic Transmit FIFO Size Register (`gnptxfSiz`)—selects the size and the start address of the non-periodic transmit FIFO buffer for nonperiodic transactions
 - c. Host Periodic Transmit FIFO Size Register (`hptxfSiz`)—selects the size and start address of the periodic transmit FIFO buffer for periodic transactions
8. System software initializes and enables at least one channel to communicate with the USB device.

Host Transaction

When configured as a host, the USB OTG controller pipes the USB transactions through one of two request queues (one for periodic transactions and one for nonperiodic transactions). Each entry in the request queue holds the SETUP, IN, or OUT channel number along with other information required to perform a transaction on the USB link. The sequence in which the requests are written to the queue determines the sequence of transactions on the USB link.

The host processes the requests in the following order at the beginning of each frame or microframe:

1. Periodic request queue, including isochronous and interrupt transactions
2. Nonperiodic request queue (bulk or control transfers)

The host schedules transactions for each enabled channel in round-robin fashion. When the host controller completes the transfer for a channel, the controller updates the DMA descriptor status in the system memory.

For OUT transactions, the host controller uses two transmit FIFO buffers to hold the packet payload to be transmitted. One transmit FIFO buffer is used for all nonperiodic OUT transactions and the other is used for all periodic OUT transactions.

For IN transactions, the USB host controller uses one receive FIFO buffer for all periodic and nonperiodic transactions. The controller holds the packet payload from the USB device in the receive FIFO buffer until the packet is transferred to the system memory. The receive FIFO buffer also holds the status of each packet received. The status entry holds the IN channel number along with other information, including received byte count and validity status.

For generic hub operations, the USB OTG controller uses SPLIT transfers to communicate with slower-speed devices downstream of the hub. For these transfers, the transaction accumulation or buffering is performed in the generic hub, and is scheduled accordingly. The USB OTG controller ensures that enough transmit and receive buffers are allocated when the downstream transactions are completed or when accumulated data is ready to be sent upstream.

Device Operation

Device Initialization

The following process sets up the USB OTG controller as a USB device:

1. After power up, the USB OTG controller must be set to the desired device speed by writing to the Device Speed (`devspd`) bits in the Device Configuration Register (`dcfg`) in the Device Mode Registers (`devgrp`) group. After the device speed is set, the controller waits for a USB host to detect the USB port as a device port.
2. When an external host detects the USB port, the host performs a port reset, which generates an interrupt to the USB device software. The USB Reset (`usbrst`) bit in the Interrupt (`port_reset`) register in the Global Registers (`globgrp`) group is set. The device software then sets up the data FIFO buffer to receive a SETUP packet from the external host. Endpoint 0 is not enabled yet.
3. After completion of the port reset, the operation speed required by the external host is known. Software reads the device speed status and sets up all the remaining required transaction fields to enable control endpoint 0.

After completion of this process, the device is receiving SOF packets, and is ready for the USB host to set up the device's control endpoint.

Device Transaction

When configured as a device, the USB OTG controller uses a single FIFO buffer to receive the data for all the OUT endpoints. The receive FIFO buffer holds the status of the received data packet, including the byte count, the data packet ID (PID), and the validity of the received data. The DMA controller reads the data out of the FIFO buffer as the data are received. If a FIFO buffer overflow condition occurs, the controller responds to the OUT packet with a NAK, and internally rewinds the pointers.

For IN endpoints, the controller uses dedicated transmit buffers for each endpoint. The application does not need to predict the order in which the USB host will access the nonperiodic endpoints. If a FIFO buffer underrun condition occurs during transmit, the controller inverts the cyclic redundancy code (CRC) to mark the packet as corrupt on the USB link.

The application handles one data packet at a time per endpoint in transaction-level operations. The software receives an interrupt on completion of every packet. Based on the handshake response received on the USB link, the application determines whether to retry the transaction or proceed with the next transaction, until all packets in the transfer are completed.

IN Transactions

For an IN transaction, the application performs the following steps:

1. Enables the endpoint
2. Triggers the DMA engine to write the associated data packet to the corresponding transmit FIFO buffer
3. Waits for the packet completion interrupt from the controller

When an IN token is received on an endpoint when the associated transmit FIFO buffer does not contain sufficient data, the controller performs the following steps:

1. Generates an interrupt
2. Returns a NAK handshake to the USB host

If sufficient data is available, the controller transmits the data to the USB host.

OUT Transactions

For an OUT transaction, the application performs the following steps:

1. Enables the endpoint
2. Waits for the packet received interrupt from the USB OTG controller
3. Retrieves the packet from the receive FIFO buffer

When an OUT token or PING token is received on an endpoint where the receive FIFO buffer does not have sufficient space, the controller performs the following steps:

1. Generates an interrupt
2. Returns a NAK handshake to USB host

If sufficient space is available, the controller stores the data in the receive FIFO buffer and returns an ACK handshake to the USB link.

Control Transfers

For control transfers, the application performs the following steps:

1. Waits for the packet received interrupt from the controller
2. Retrieves the packet from the receive buffer

Because the control transfer is governed by USB protocol, the controller always responds with an ACK handshake.

USB OTG Controller Address Map and Register Definitions



The address map and register definitions reside in the [hps.html](#) file that accompanies this handbook volume. Click the link to open the file.

To view the module description and base address, scroll to and click the link for either of the following module instances:

- **usb0**
- **usb1**

To then view the register and field descriptions, scroll to and click the register names. The register addresses are offsets relative to the base address of each module instance.



The base addresses of all modules are also listed in the *Introduction to the Hard Processor System* chapter in volume 3 of the *Cyclone V Device Handbook*.

Document Revision History

Table 18-5 shows the revision history for this document.

Table 18-5. Document Revision History

Date	Version	Changes
November 2012	1.2	<ul style="list-style-type: none"> Described interrupt generation. Described software initialization in host and device modes. Described software operation in host and device modes. Simplified features list. Simplified hardware description.
June 2012	1.1	Added information about ECCs.
January 2012	1.0	Initial release.

The hard processor system (HPS) provides two serial peripheral interface (SPI) masters and two SPI slaves. The SPI masters and slaves are instances of the Synopsys® DesignWare® Synchronous Serial Interface (SSI) controller (DW_apb_ssi).

Features of the SPI Controller

The SPI controller has the following features: †

- Serial master and serial slave controllers – Enable serial communication with serial-master or serial-slave peripheral devices. †
- Serial interface operation – Programmable choice of the following protocols:
 - Motorola SPI protocol
 - Texas Instruments Synchronous Serial Protocol
 - National Semiconductor Microwire
- DMA controller interface integrated with HPS DMA controller
- SPI master supports rxd sample delay
- Transmit and receive FIFO buffers are 256 words deep
- SPI master supports up to four slave selects
- Programmable master serial bit rate
- Programmable data item size of 4 to 16 bits

SPI Block Diagram and System Integration

The SPI supports data bus widths of 32 bits. †

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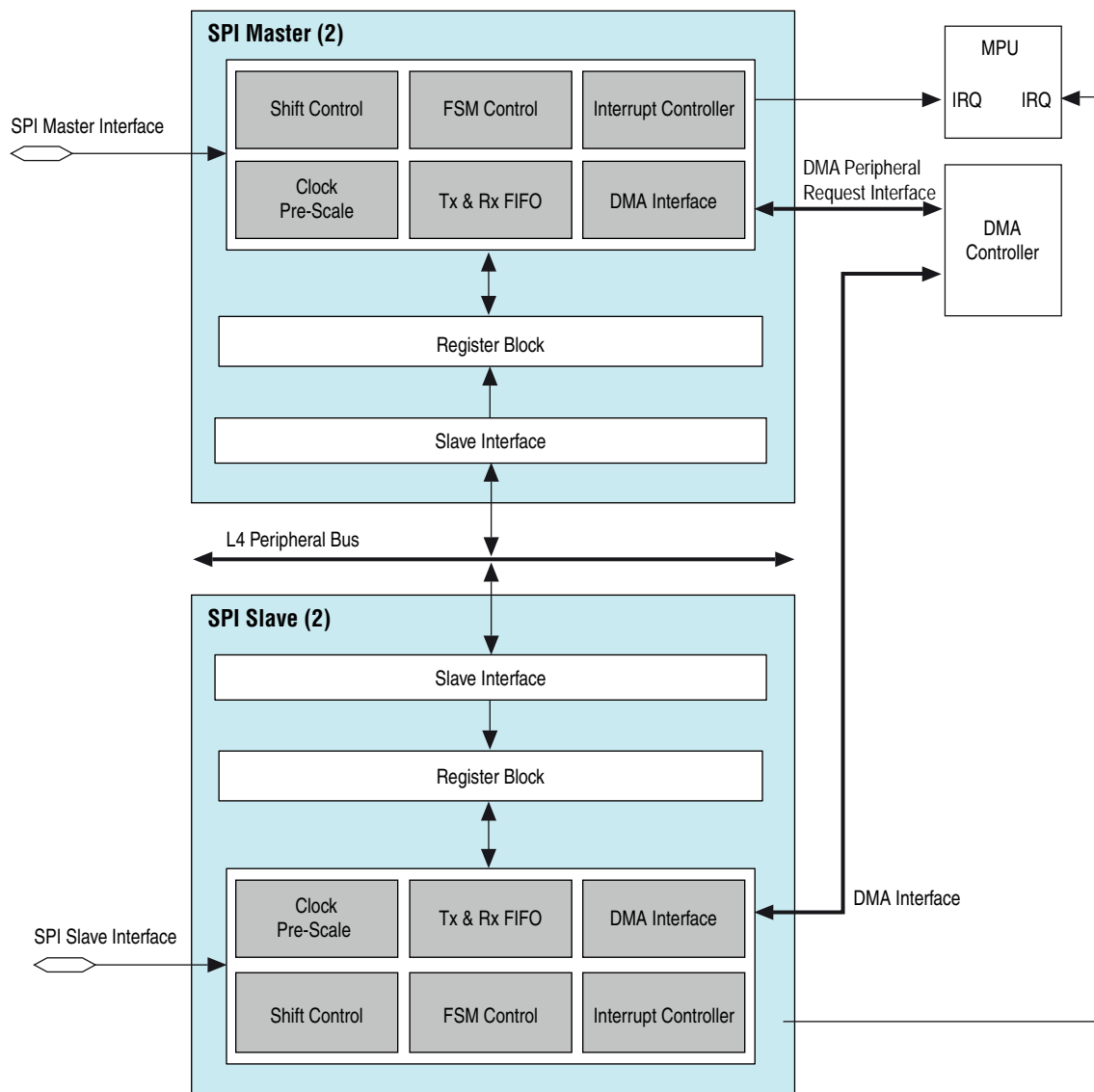
†Paragraphs marked with the dagger (†) symbol are Synopsys Proprietary. Used with permission.



SPI Block Diagram

Figure 19-1 shows the functional groupings of the main interfaces to the SPI block. †

Figure 19-1. SPI Block Diagram



The functional groupings of the main interfaces to the SPI block are as follows: †

- System bus interface
- DMA peripheral request interface
- Interrupt interface
- SPI interface

Functional Description of the SPI Controller

Protocol Details and Standards Compliance

This chapter describes the functional operation of the SPI controller. †

The host processor accesses data, control, and status information about the SPI controller through the system bus interface. The SPI also interfaces with the DMA Controller. †

The HPS includes two general-purpose SPI master controllers and two general-purpose SPI slave controllers.

The SPI controller can connect to any other SPI device using any of the following protocols:

- Motorola SPI Protocol †
- Texas Instruments Serial Protocol (SSP) †
- National Semiconductor Microwire Protocol †

SPI Controller Overview

In order for the SPI controller to connect to a serial-master or serial-slave peripheral device, the peripheral must have a least one of the following interfaces: †

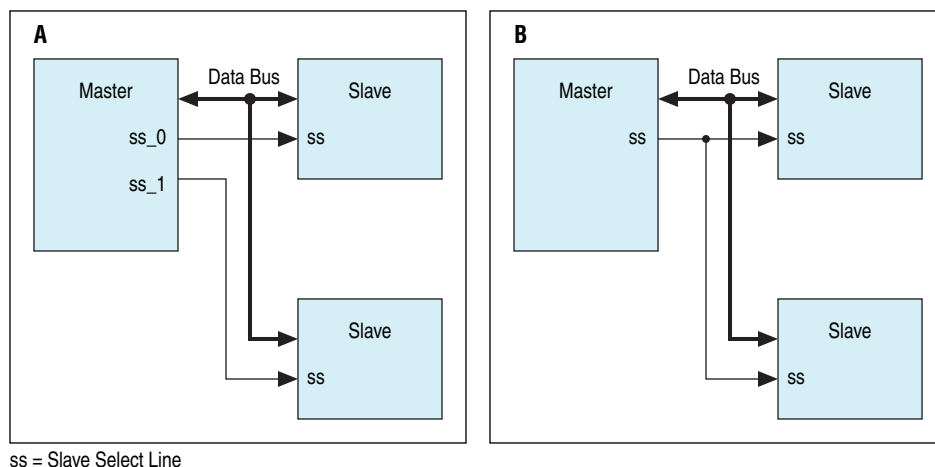
- Motorola SPI protocol – A four-wire, full-duplex serial protocol from Motorola. The slave select line is held high when the SPI controller is idle or disabled. For more information, refer to “[Motorola SPI Protocol](#)” on page 19–13. †
- Texas Instruments Serial Protocol (SSP) – A four-wire, full-duplex serial protocol. The slave select line used for SPI and Microwire protocols doubles as the frame indicator for the SSP protocol. For more information, refer to “[Texas Instruments Synchronous Serial Protocol \(SSP\)](#)” on page 19–14. †
- National Semiconductor Microwire – A half-duplex serial protocol, which uses a control word transmitted from the serial master to the target serial slave. For more information, refer to “[National Semiconductor Microwire Protocol](#)” on page 19–15. You can program the FRF (frame format) bit field in the Control Register 0 (CTRLR0) to select which protocol is used. †

The serial protocols supported by the SPI controller allow for serial slaves to be selected or addressed using hardware. Serial slaves are selected under the control of dedicated hardware select lines. The number of select lines generated from the serial master is equal to the number of serial slaves present on the bus. The serial-master device asserts the select line of the target serial slave before data transfer begins. This architecture is illustrated in part A of [Figure 19–2](#). †

When implemented in software, the input select line for all serial slave devices should originate from a single slave select output on the serial master. In this mode it is assumed that the serial master has only a single slave select output. If there are multiple serial masters in the system, the slave select output from all masters can be logically ANDed to generate a single slave select input for all serial slave devices. †

The main program in the software domain controls selection of the target slave device; this architecture is illustrated in part B of Figure 19-2. Software would control which slave is to respond to the serial transfer request from the master device. †

Figure 19-2. Hardware/Software Slave Selection †

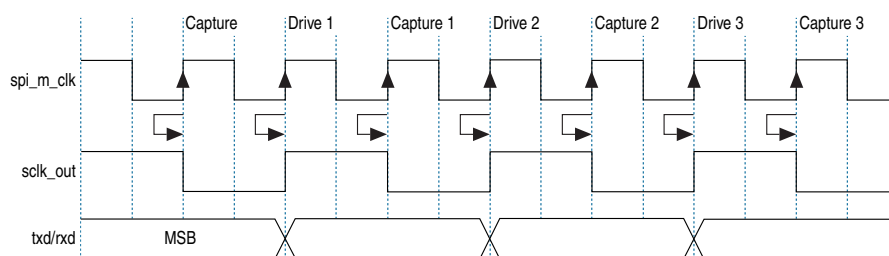


Serial Bit-Rate Clocks

SPI Master Bit-Rate Clock

The maximum frequency of the SPI master bit-rate clock (`sclk_out`) is one-half the frequency of SPI master clock (`spi_m_clk`). This allows the shift control logic to capture data on one clock edge of `sclk_out` and propagate data on the opposite edge, as shown in Figure 19-3. The `sclk_out` line toggles only when an active transfer is in progress. At all other times it is held in an inactive state, as defined by the serial protocol under which it operates. †

Figure 19-3. Maximum `sclk_out`/`spi_m_clk` Ratio



The frequency of `sclk_out` can be derived from Equation 19-1, where `<SPI clock>` is `spi_m_clk` for the master SPI modules and `l4_main_clk` for the slave SPI modules. †

Equation 19-1.

$$F_{\text{sclk_out}} = F_{\text{<SPI clock>}} / \text{SCKDV}$$

SCKDV is a bit field in the register `BAUDR`, holding any even value in the range 2 to 65,534. If SCKDV is 0, then `sclk_out` is disabled. †

Equation 19-2 describes the frequency ratio restrictions between the bit-rate clock `sclk_out` and the SPI master peripheral clock. The SPI master peripheral clock must be at least double the offchip master clock. †

Equation 19-2. SPI Master Peripheral Clock

$$F_{\text{spl_m_clk}} \geq 2 \times (\text{maximum } F_{\text{sclk_out}}) \dagger$$

SPI Slave Bit-Rate Clock

The minimum frequency of `l4_main_clk` depends on the operation of the slave peripheral. If the slave device is *receive only*, the minimum frequency of `l4_main_clk` is six times the maximum expected frequency of the bit-rate clock from the master device (`sclk_in`). The `sclk_in` signal is double synchronized to the `l4_main_clk` domain, and then it is edge detected; this synchronization requires three `l4_main_clk` periods. †

If the slave device is *transmit and receive*, the minimum frequency of `l4_main_clk` is eight times the maximum expected frequency of the bit-rate clock from the master device (`sclk_in`). This ensures that data on the master `rx` line is stable before the master shift control logic captures the data. †

The frequency ratio restrictions between the bit-rate clock `sclk_in` and the SPI slave peripheral clock are as follows: †

- Slave (receive only): $F_{\text{l4_main_clk}} \geq 6 \times (\text{maximum } F_{\text{sclk_in}}) \dagger$
- Slave: $F_{\text{l4_main_clk}} \geq 8 \times (\text{maximum } F_{\text{sclk_in}}) \dagger$

Transmit and Receive FIFO Buffers

There are two 16-bit FIFO buffers, a transmit FIFO buffer and a receive FIFO buffer, with a depth of 256. Data frames that are less than 16 bits in size must be right-justified when written into the transmit FIFO buffer. The shift control logic automatically right-justifies receive data in the receive FIFO buffer. †

Each data entry in the FIFO buffers contains a single data frame. It is impossible to store multiple data frames in a single FIFO buffer location; for example, you may not store two 8-bit data frames in a single FIFO buffer location. If an 8-bit data frame is required, the upper 8-bits of the FIFO buffer entry are ignored or unused when the serial shifter transmits the data. †



The transmit and receive FIFO buffers are cleared when the SPI controller is disabled (`SSIENR=0`) or reset. For detailed information about reset signals, refer to the [Reset Manager](#) chapter in volume 3 of the *Cyclone® V Device Handbook*.

The transmit FIFO buffer is loaded by write commands to the SPI data register (`DR`). Data are popped (removed) from the transmit FIFO buffer by the shift control logic into the transmit shift register. The transmit FIFO buffer generates a transmit FIFO empty interrupt request when the number of entries in the FIFO buffer is less than or equal to the FIFO buffer threshold value. The threshold value, set through the register `TXFTLR`, determines the level of FIFO buffer entries at which an interrupt is generated. The threshold value allows you to provide early indication to the processor that the transmit FIFO buffer is nearly empty. A Transmit FIFO Overflow Interrupt is generated if you attempt to write data into an already full transmit FIFO buffer. †

Data are popped from the receive FIFO buffer by read commands to the SPI data register (DR). The receive FIFO buffer is loaded from the receive shift register by the shift control logic. The receive FIFO buffer generates a receive FIFO full interrupt request when the number of entries in the FIFO buffer is greater than or equal to the FIFO buffer threshold value plus one. The threshold value, set through register `RXFTHR`, determines the level of FIFO buffer entries at which an interrupt is generated. †

The threshold value allows you to provide early indication to the processor that the receive FIFO buffer is nearly full. A Receive FIFO Overflow Interrupt is generated when the receive shift logic attempts to load data into a completely full receive FIFO buffer. However, the newly received data are lost. A Receive FIFO Underflow Interrupt is generated if you attempt to read from an empty receive FIFO buffer. This alerts the processor that the read data are invalid. †

SPI Interrupts

The SPI controller supports combined interrupt requests, which can be masked. The combined interrupt request is the ORed result of all other SPI interrupts after masking. All SPI interrupts have active-high polarity level. The SPI interrupts are described as follows: †

- Transmit FIFO Empty Interrupt – Set when the transmit FIFO buffer is equal to or below its threshold value and requires service to prevent an underrun. The threshold value, set through a software-programmable register, determines the level of transmit FIFO buffer entries at which an interrupt is generated. This interrupt is cleared by hardware when data are written into the transmit FIFO buffer, bringing it over the threshold level. †
- Transmit FIFO Overflow Interrupt – Set when a master attempts to write data into the transmit FIFO buffer after it has been completely filled. When set, new data writes are discarded. This interrupt remains set until you read the transmit FIFO overflow interrupt clear register (`TXOICR`). †
- Receive FIFO Full Interrupt – Set when the receive FIFO buffer is equal to or above its threshold value plus 1 and requires service to prevent an overflow. The threshold value, set through a software-programmable register, determines the level of receive FIFO buffer entries at which an interrupt is generated. This interrupt is cleared by hardware when data are read from the receive FIFO buffer, bringing it below the threshold level. †
- Receive FIFO Overflow Interrupt – Set when the receive logic attempts to place data into the receive FIFO buffer after it has been completely filled. When set, newly received data are discarded. This interrupt remains set until you read the receive FIFO overflow interrupt clear register (`RXOICR`). †
- Receive FIFO Underflow Interrupt – Set when a system bus access attempts to read from the receive FIFO buffer when it is empty. When set, zeros are read back from the receive FIFO buffer. This interrupt remains set until you read the receive FIFO underflow interrupt clear register (`RXUICR`). †
- Combined Interrupt Request – ORed result of all the above interrupt requests after masking. To mask this interrupt signal, you must mask all other SPI interrupt requests. †

Transmit FIFO Overflow, Transmit FIFO Empty, Receive FIFO Full, Receive FIFO Underflow, and Receive FIFO Overflow interrupts can all be masked independently, using the Interrupt Mask Register (IMR). †

Transfer Modes

When transferring data on the serial bus, the SPI controller operates in the modes discussed in this section.

The transfer mode (TMOD) is set by writing to control register 0 (CTRLR0). †



The transfer mode setting does not affect the duplex of the serial transfer. TMOD is ignored for Microwire transfers, which are controlled by the MWCR register. †

Transmit and Receive

When TMOD = 0, both transmit and receive logic are valid. The data transfer occurs as normal according to the selected frame format (serial protocol). Transmit data are popped from the transmit FIFO buffer and sent through the `txd` line to the target device, which replies with data on the `rxn` line. The receive data from the target device is moved from the receive shift register into the receive FIFO buffer at the end of each data frame. †

Transmit Only

When TMOD = 1, any receive data are ignored. The data transfer occurs as normal, according to the selected frame format (serial protocol). Transmit data are popped from the transmit FIFO buffer and sent through the `txd` line to the target device, which replies with data on the `rxn` line. At the end of the data frame, the receive shift register does not load its newly received data into the receive FIFO buffer. The data in the receive shift register is overwritten by the next transfer. You should mask interrupts originating from the receive logic when this mode is entered. †

Receive Only

When TMOD = 2, the transmit data are invalid. In the case of the SPI slave, the transmit FIFO buffer is never popped in Receive Only mode. The `txd` output remains at a constant logic level during the transmission. The data transfer occurs as normal according to the selected frame format (serial protocol). The receive data from the target device is moved from the receive shift register into the receive FIFO buffer at the end of each data frame. You should mask interrupts originating from the transmit logic when this mode is entered. †

EEPROM Read



This transfer mode is only valid for serial masters. †

When $TMOD = 3$, the transmit data is used to transmit an opcode and/or an address to the EEPROM device. Typically this takes three data frames (8-bit opcode followed by 8-bit upper address and 8-bit lower address). During the transmission of the opcode and address, no data is captured by the receive logic (as long as the SPI master is transmitting data on its `txd` line, data on the `rx` line is ignored). The SPI master continues to transmit data until the transmit FIFO buffer is empty. Therefore, you should ONLY have enough data frames in the transmit FIFO buffer to supply the opcode and address to the EEPROM. If more data frames are in the transmit FIFO buffer than are needed, then read data is lost. †

When the transmit FIFO buffer becomes empty (all control information has been sent), data on the receive line (`rx`) is valid and is stored in the receive FIFO buffer; the `txd` output is held at a constant logic level. The serial transfer continues until the number of data frames received by the SPI master matches the value of the NDF field in the `CTRLR1` register plus one. †



EEPROM read mode is not supported when the SPI controller is configured to be in the SSP mode. †

SPI Master

The SPI master initiates and controls all serial transfers with serial-slave peripheral devices. [Figure 19-1 on page 19-2](#) shows a SPI master. †

The serial bit-rate clock, generated and controlled by the SPI controller, is driven out on the `sclk_out` line. When the SPI controller is disabled, no serial transfers can occur and `sclk_out` is held in “inactive” state, as defined by the serial protocol under which it operates. †

RXD Sample Delay

SPI master device is capable of delaying the default sample time of the `rx` signal in order to increase the maximum achievable frequency on the serial bus.

Round trip routing delays on the `sclk_out` signal from the master and the `rx` signal from the slave can mean that the timing of the `rx` signal, as seen by the master, has moved away from the normal sampling time.

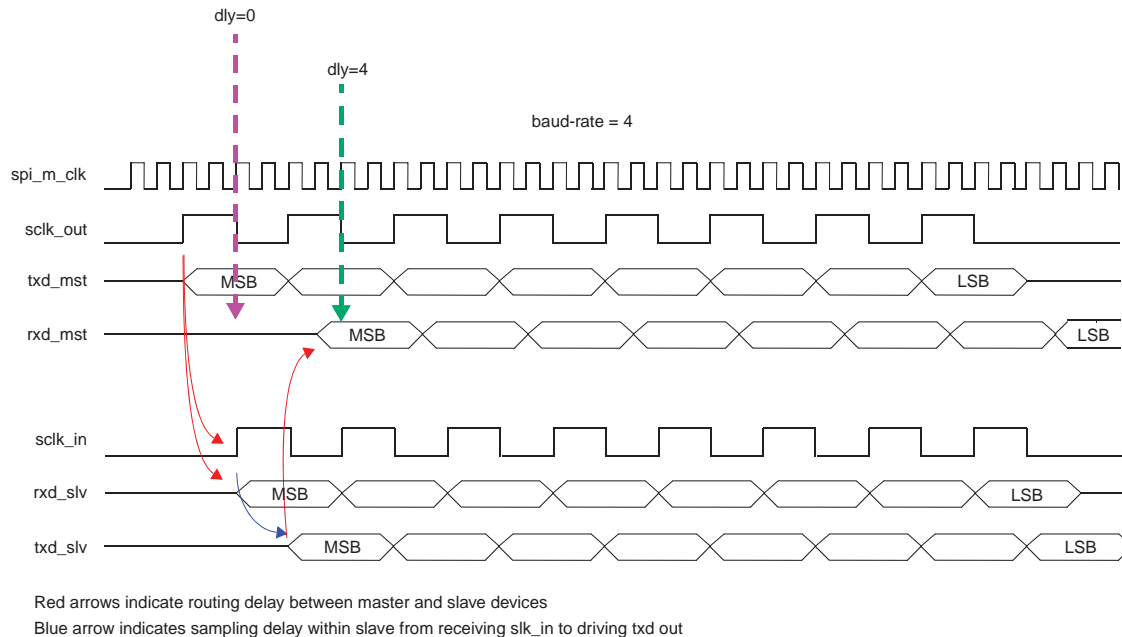
Without the RXD sample delay, you must increase the baud rate for the transfer in order to ensure that the setup times on the `rx` signal are within range. This reduces the frequency of the serial interface.

Additional logic is included in the SPI master to delay the default sample time of the `rx` signal. This additional logic can help to increase the maximum achievable frequency on the serial bus. †

By writing to the `rsd` field of the RX Sample Delay Register (`rx_sample_dly`), you specify an additional amount of delay applied to the `rx` sample, in number of `spi_m_clk` clock cycles, up to 64 cycles. If the `rsd` field is programmed with a value exceeding 64, zero delay is applied to the `rx` sample.

Round trip routing delays on the `sclk_out` signal from the master and the `rx_d` signal from the slave can mean that the timing of the `rx_d` signal, as seen by the master, has moved away from the normal sampling time. Figure 19-4 illustrates this situation. Red arrows indicate routing delay between master and slave devices. Blue arrow indicates sampling delay within slave from receiving `sclk_in` to driving `tx_d` out. †

Figure 19-4. Effects of Round-Trip Routing Delays on `sclk_out` Signal



Data Transfers

The SPI master starts data transfers when all the following conditions are met:

- The SPI master is enabled
- There is at least one valid entry in the transmit FIFO buffer
- A slave device is selected

When actively transferring data, the busy flag (`BUSY`) in the status register (`SR`) is set. You must wait until the busy flag is cleared before attempting a new serial transfer. †



The `BUSY` status is not set when the data are written into the transmit FIFO buffer. This bit gets set only when the target slave has been selected and the transfer is underway. After writing data into the transmit FIFO buffer, the shift logic does not begin the serial transfer until a positive edge of the `sclk_out` signal is present. The delay in waiting for this positive edge depends on the baud rate of the serial transfer. Before polling the `BUSY` status, you should first poll the Transit FIFO Empty (`TFE`) status (waiting for 1) or wait for $(\text{BAUDR} * \text{SPI clock})$ clock cycles. †

Master SPI and SSP Serial Transfers

“Motorola SPI Protocol” on page 19-13 and “Texas Instruments Synchronous Serial Protocol (SSP)” on page 19-14 describe the SPI and SSP serial protocols, respectively. †

When the transfer mode is “transmit and receive” or “transmit only” (TMOD = 0 or TMOD = 1, respectively), transfers are terminated by the shift control logic when the transmit FIFO buffer is empty. For continuous data transfers, you must ensure that the transmit FIFO buffer does not become empty before all the data have been transmitted. The transmit FIFO threshold level (TXFTLR) can be used to early interrupt (Transmit FIFO Empty Interrupt) the processor indicating that the transmit FIFO buffer is nearly empty. †

When the DMA is used in conjunction with the SPI master, the transmit data level (DMATDLR) can be used to early request the DMA Controller, indicating that the transmit FIFO buffer is nearly empty. The FIFO buffer can then be refilled with data to continue the serial transfer. The user may also write a block of data (at least two FIFO buffer entries) into the transmit FIFO buffer before enabling a serial slave. This ensures that serial transmission does not begin until the number of data frames that make up the continuous transfer are present in the transmit FIFO buffer. †

When the transfer mode is “receive only” (TMOD = 2), a serial transfer is started by writing one “dummy” data word into the transmit FIFO buffer when a serial slave is selected. The txd output from the SPI controller is held at a constant logic level for the duration of the serial transfer. The transmit FIFO buffer is popped only once at the beginning and may remain empty for the duration of the serial transfer. The end of the serial transfer is controlled by the “number of data frames” (NDF) field in control register 1 (CTRLR1). †

If, for example, you want to receive 24 data frames from a serial-slave peripheral, you should program the NDF field with the value 23; the receive logic terminates the serial transfer when the number of frames received is equal to the NDF value plus one. This transfer mode increases the bandwidth of the system bus as the transmit FIFO buffer never needs to be serviced during the transfer. The receive FIFO buffer should be read each time the receive FIFO buffer generates a FIFO full interrupt request to prevent an overflow. †

When the transfer mode is “eeprom_read” (TMOD = 3), a serial transfer is started by writing the opcode and/or address into the transmit FIFO buffer when a serial slave (EEPROM) is selected. The opcode and address are transmitted to the EEPROM device, after which read data is received from the EEPROM device and stored in the receive FIFO buffer. The end of the serial transfer is controlled by the NDF field in the control register 1 (CTRLR1). †



EEPROM read mode is not supported when the SPI controller is configured to be in the SSP mode. †

The receive FIFO threshold level (RXFTLR) can be used to give early indication that the receive FIFO buffer is nearly full. When a DMA is used, the receive data level (DMARDLR) can be used to early request the DMA Controller, indicating that the receive FIFO buffer is nearly full. †

Master Microwire Serial Transfers

“National Semiconductor Microwire Protocol” on page 19-15 describes the Microwire serial protocol in detail. †

Microwire serial transfers from the SPI serial master are controlled by the Microwire Control Register (MWCR). The MHS bit field enables and disables the Microwire handshaking interface. The MDD bit field controls the direction of the data frame (the control frame is always transmitted by the master and received by the slave). The MWMOD bit field defines whether the transfer is sequential or nonsequential. †

All Microwire transfers are started by the SPI serial master when there is at least one control word in the transmit FIFO buffer and a slave is enabled. When the SPI master transmits the data frame (MDD = 1), the transfer is terminated by the shift logic when the transmit FIFO buffer is empty. When the SPI master receives the data frame (MDD = 1), the termination of the transfer depends on the setting of the MWMOD bit field. If the transfer is nonsequential (MWMOD = 0), it is terminated when the transmit FIFO buffer is empty after shifting in the data frame from the slave. When the transfer is sequential (MWMOD = 1), it is terminated by the shift logic when the number of data frames received is equal to the value in the CTRLR1 register plus one. †

When the handshaking interface on the SPI master is enabled (MHS = 1), the status of the target slave is polled after transmission. Only when the slave reports a *ready status* does the SPI master complete the transfer and clear its BUSY status. If the transfer is continuous, the next control/data frame is not sent until the slave device returns a *ready status*. †

SPI Slave

The SPI slave handles serial communication with transfer initiated and controlled by serial master peripheral devices.

Figure 19-5 shows an example of a SPI slave in a single-master bus system, including the following signals: †

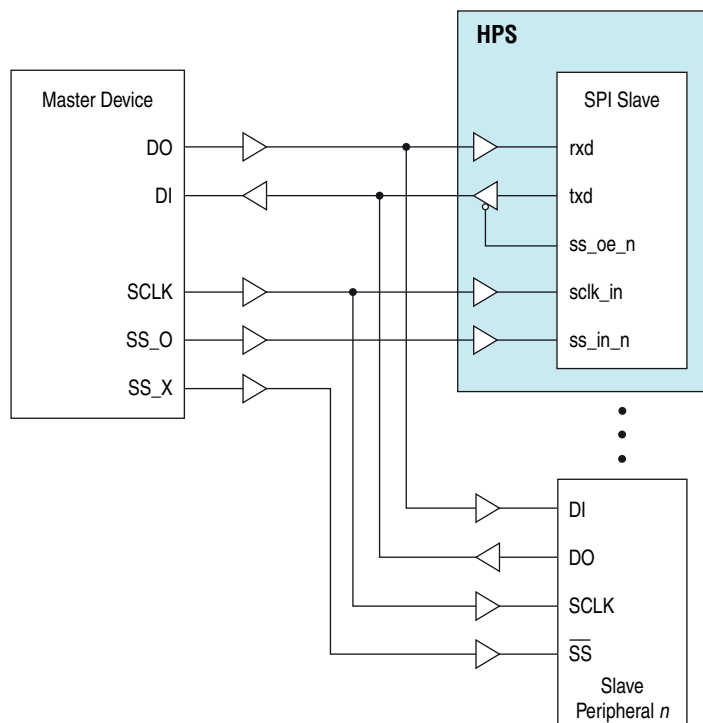
- `sclk_in`—serial clock to the SPI slave †
- `ss_in_n`—slave select input to the SPI slave †
- `ss_oe_n`—output enable for the SPI master or slave †
- `txd`—transmit data line for the SPI master or slave †
- `rxn`—receive data line for the SPI master or slave †

When the SPI serial slave is selected, it enables its `txd` data onto the serial bus. All data transfers to and from the serial slave are regulated on the serial clock line (`sclk_in`), driven from the SPI master device. Data are propagated from the serial slave on one edge of the serial clock line and sampled on the opposite edge. †

When the SPI serial slave is not selected, it must not interfere with data transfers between the serial-master and other serial-slave devices. When the serial slave is not selected, its `txd` output is buffered, resulting in a high impedance drive onto the SPI master `rxn` line. The buffers shown in Figure 19-5 are external to SPI controller. `spi_oe_n` is the SPI slave output enable signal. †

The serial clock that regulates the data transfer is generated by the serial-master device and input to the SPI slave on `sclk_in`. The slave remains in an idle state until selected by the bus master. When not actively transmitting data, the slave must hold its `txd` line in a high impedance state to avoid interference with serial transfers to other slave devices. The SPI slave output enable (`ss_oe_n`) signal is available for use to control the `txd` output buffer. The slave continues to transfer data to and from the master device as long as it is selected. If the master transmits to all serial slaves, a control bit (`SLV_OE`) in the SPI control register 0 (`CTRLR0`) can be programmed to inform the slave if it should respond with data from its `txd` line. †

Figure 19-5. SPI Slave †



Slave SPI and SSP Serial Transfers †

“Motorola SPI Protocol” on page 19-13 and “Texas Instruments Synchronous Serial Protocol (SSP)” on page 19-14 contain a description of the SPI and SSP serial protocols, respectively. †

If the SPI slave is *receive only* (`TMOD=2`), the transmit FIFO buffer need not contain valid data because the data currently in the transmit shift register is resent each time the slave device is selected. The `TXE` error flag in the status register (`SR`) is not set when `TMOD=2`. You should mask the Transmit FIFO Empty Interrupt when this mode is used. †

If the SPI slave transmits data to the master, you must ensure that data exists in the transmit FIFO buffer before a transfer is initiated by the serial-master device. If the master initiates a transfer to the SPI slave when no data exists in the transmit FIFO buffer, an error flag (`TXE`) is set in the SPI status register, and the previously transmitted data frame is resent on `txd`. For continuous data transfers, you must ensure that the transmit FIFO buffer does not become empty before all the data have

been transmitted. The transmit FIFO threshold level register (TXFTLR) can be used to early interrupt (Transmit FIFO Empty Interrupt) the processor, indicating that the transmit FIFO buffer is nearly empty. When a DMA Controller is used, the DMA transmit data level register (DMATDLR) can be used to early request the DMA Controller, indicating that the transmit FIFO buffer is nearly empty. The FIFO buffer can then be refilled with data to continue the serial transfer. †

The receive FIFO buffer should be read each time the receive FIFO buffer generates a FIFO full interrupt request to prevent an overflow. The receive FIFO threshold level register (RXFTLR) can be used to give early indication that the receive FIFO buffer is nearly full. When a DMA Controller is used, the DMA receive data level register (DMARDLR) can be used to early request the DMA controller, indicating that the receive FIFO buffer is nearly full. †

Serial Transfers

“National Semiconductor Microwire Protocol” on page 19-15 describes the Microwire serial protocol in detail, including timing diagrams and information about how data are structured in the transmit and receive FIFO buffers before and after a serial transfer. The Microwire protocol operates in much the same way as the SPI protocol. There is no decode of the control frame by the SPI slave device. †

Partner Connection Interfaces

The SPI can connect to any serial-master or serial-slave peripheral device using one of the interfaces discussed in the following sections. †

Motorola SPI Protocol

The inactive state of the serial clock is low. The data frame can be 4 to 16 bits in length. †

Data transmission begins on the falling edge of the slave select signal. The first data bit is captured by the master and slave peripherals on the first edge of the serial clock; therefore, valid data must be present on the txd and rxd lines prior to the first serial clock edge. †



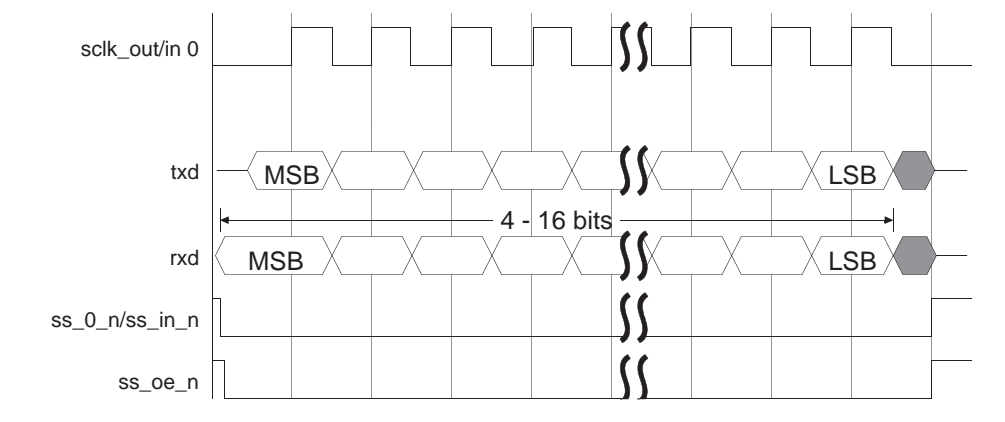
The slave select signal takes effect only when used as slave SPI. For master SPI, the data transmission begins as soon as the output enable signal is deasserted.

Figure 19-6 shows a timing diagram for a single SPI data transfer. †

The following signals are illustrated in the timing diagrams in this section: †

- sclk_out—serial clock from SPI master †
- sclk_in—serial clock from SPI slave †
- ss_0_n—slave select signal from SPI master †
- ss_oe_n—output enable for the SPI master or slave †

- txd—transmit data line for the SPI master or slave †
- rxd—receive data line for the SPI master or slave †

Figure 19-6. SPI Serial Format

There are four possible transfer modes on the SPI controller for performing SPI serial transactions; refer to “[Transfer Modes](#)” on page 19-7. For *transmit and receive transfers* (transfer mode field (9:8) of the Control Register 0 = 0), data transmitted from the SPI controller to the external serial device is written into the transmit FIFO buffer. Data received from the external serial device into the SPI controller is pushed into the receive FIFO buffer. †

For *transmit only* transfers (transfer mode field (9:8) of the Control Register 0 = 1), data transmitted from the SPI controller to the external serial device is written into the transmit FIFO buffer. As the data received from the external serial device is deemed invalid, it is not stored in the SPI receive FIFO buffer. †

For *receive only* transfers (transfer mode field (9:8) of the Control Register 0 = 2), data transmitted from the SPI controller to the external serial device is invalid, so a single dummy word is written into the transmit FIFO buffer to begin the serial transfer. The txd output from the SPI controller is held at a constant logic level for the duration of the serial transfer. Data received from the external serial device into the SPI controller is pushed into the receive FIFO buffer. †

For *EEPROM read* transfers (transfer mode field [9:8] of the Control Register 0 = 3), opcode and/or EEPROM address are written into the transmit FIFO buffer. During transmission of these control frames, received data is not captured by the SPI master. After the control frames have been transmitted, receive data from the EEPROM is stored in the receive FIFO buffer.

Texas Instruments Synchronous Serial Protocol (SSP)

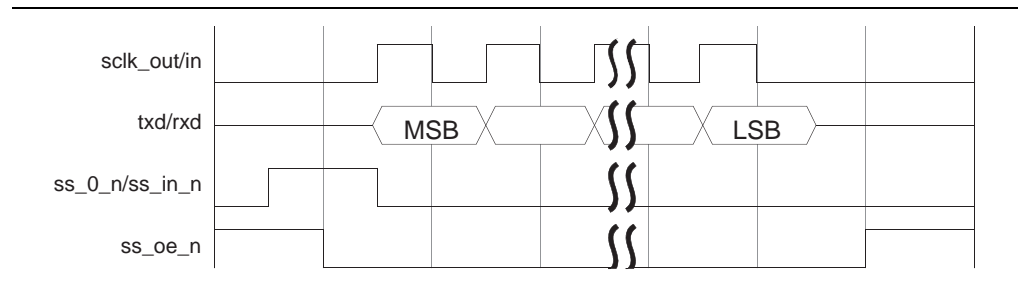
Data transfers begin by asserting the frame indicator line (ss_0_n) for one serial clock period. Data to be transmitted are driven onto the txd line one serial clock cycle later; similarly data from the slave are driven onto the rxd line. Data are propagated on the rising edge of the serial clock (sclk_out/sclk_in) and captured on the falling edge. The length of the data frame ranges from 4 to 16 bits.



The slave select signal (ss_0_n) takes effect only when used as slave SPI. For master SPI, the data transmission begins as soon as the output enable signal is deasserted.

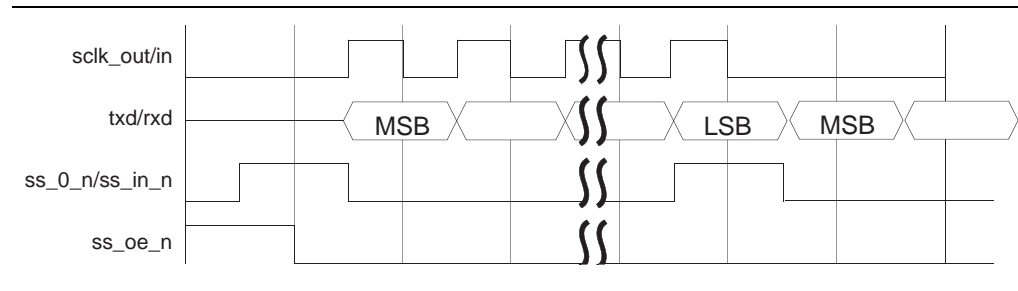
Figure 19-7 shows the timing diagram for a single SSP serial transfer. †

Figure 19-7. SSP Serial Format



Continuous data frames are transferred in the same way as single data frames. The frame indicator is asserted for one clock period during the same cycle as the LSB from the current transfer, indicating that another data frame follows. Figure 19-8 shows the timing for a continuous SSP transfer. †

Figure 19-8. SSP Serial Format Continuous Transfer



National Semiconductor Microwire Protocol

For the master SPI, data transmission begins as soon as the output enable signal is deasserted. One-half serial clock (`sclk_out`) period later, the first bit of the control is sent out on the `txd` line. The length of the control word can be in the range 1 to 16 bits and is set by writing bit field CFS (bits 15:12) in `CTRLR0`. The remainder of the control word is transmitted (propagated on the falling edge of `sclk_out`) by the SPI serial master. During this transmission, no data are present (high impedance) on the serial master's `rx` line. †

The direction of the data word is controlled by the MDD bit field (bit 1) in the Microwire Control Register (`MWCR`). When `MDD=0`, this indicates that the SPI serial master receives data from the external serial slave. One clock cycle after the LSB of the control word is transmitted, the slave peripheral responds with a dummy 0 bit, followed by the data frame, which can be 4 to 16 bits in length. Data are propagated on the falling edge of the serial clock and captured on the rising edge. †

Continuous transfers from the Microwire protocol can be sequential or nonsequential, and are controlled by the `MWMOD` bit field (bit 0) in the `MWCR`. †

Nonsequential continuous transfers occur, with the control word for the next transfer following immediately after the LSB of the current data word. †

The only modification needed to perform a continuous nonsequential transfer is to write more control words into the transmit FIFO buffer. †

During sequential continuous transfers, only one control word is transmitted from the SPI master. The transfer is started in the same manner as with nonsequential read operations, but the cycle is continued to read further data. The slave device automatically increments its address pointer to the next location and continues to provide data from that location. Any number of locations can be read in this manner; the SPI master terminates the transfer when the number of words received is equal to the value in the CTRLR1 register plus one. †

When MDD = 1, this indicates that the SPI serial master transmits data to the external serial slave. Immediately after the LSB of the control word is transmitted, the SPI master begins transmitting the data frame to the slave peripheral. †



The SPI controller does not support continuous sequential Microwire writes, where MDD = 1 and MWMOD = 1. †

Continuous transfers occur with the control word for the next transfer following immediately after the LSB of the current data word.

The Microwire handshaking interface can also be enabled for SPI master write operations to external serial-slave devices. To enable the handshaking interface, you must write 1 into the MHS bit field (bit 2) on the MWCR register. When MHS is set to 1, the SPI serial master checks for a ready status from the slave device before completing the transfer, or transmitting the next control word for continuous transfers. †

After the first data word has been transmitted to the serial-slave device, the SPI master polls the rxd input waiting for a ready status from the slave device. Upon reception of the ready status, the SPI master begins transmission of the next control word. After transmission of the last data frame has completed, the SPI master transmits a start bit to clear the ready status of the slave device before completing the transfer. †

In the SPI slave, data transmission begins with the falling edge of the slave select signal (*ss_in_0*). One-half serial clock (*sclk_in*) period later, the first bit of the control is present on the rxd line. The length of the control word can be in the range of 1 to 16 bits and is set by writing bit field CFS in the CTRLR0 register. The CFS bit field must be set to the size of the expected control word from the serial master. The remainder of the control word is received (captured on the rising edge of *sclk_in*) by the SPI serial slave. During this reception, no data are driven (high impedance) on the serial slave's txd line. †

The direction of the data word is controlled by the MDD bit field (bit 1) MWCR register. When MDD=0, this indicates that the SPI serial slave is to receive data from the external serial master. Immediately after the control word is transmitted, the serial master begins to drive the data frame onto the SPI slave rxd line. Data are propagated on the falling edge of the serial clock and captured on the rising edge. The slave-select signal is held active-low during the transfer and is deasserted one-half clock cycle later after the data are transferred. The SPI slave output enable signal is held inactive for the duration of the transfer. †

When MDD=1, this indicates that the SPI serial slave transmits data to the external serial master. Immediately after the LSB of the control word is transmitted, the SPI slave transmits a dummy 0 bit, followed by the 4- to 16-bit data frame on the txd line. †

Continuous transfers for a SPI slave occur in the same way as those specified for the SPI master. The SPI slave does not support the handshaking interface, as there is never a busy period. †

Figure 19-9 shows the timing diagram for a single SPI serial master read from an external serial slave.

Figure 19-9. Single SPI Serial Master Microwire Serial Transfer (MDD=0)

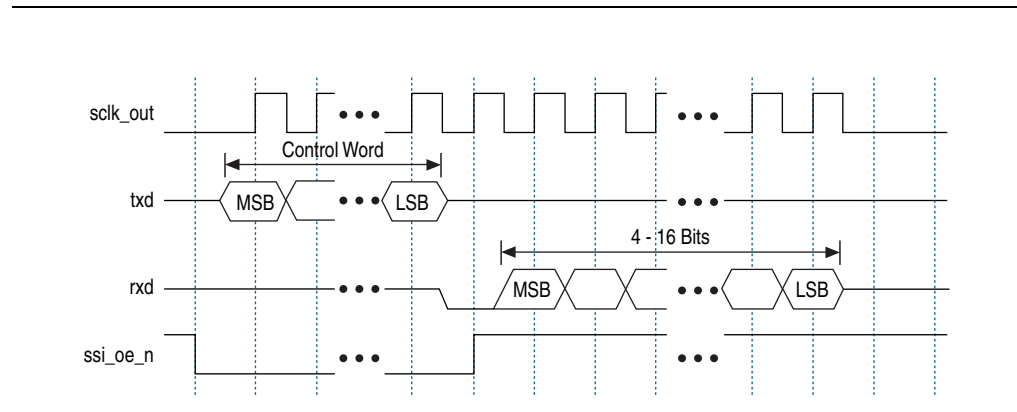
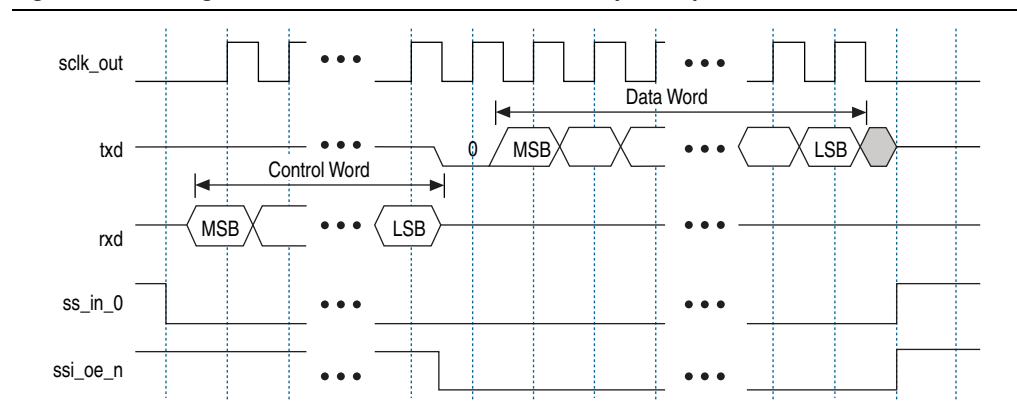


Figure 19-10 shows the timing diagram for a single SPI serial slave write to an external serial master.

Figure 19-10. Single SPI Slave Microwire Serial Transfer (MDD=1)



DMA Controller Interface

The SPI controller supports DMA signaling to indicate when the receive FIFO buffer has data ready to be read or when the transmit FIFO buffer needs data. It requires two DMA channels, one for transmit data and one for receive data. The SPI controller can issue single or burst DMA transfers and accepts burst acknowledges from the DMA. System software can trigger the DMA burst mode by programming an appropriate value into the threshold registers. The typical setting of the threshold register value is half full.

To enable the DMA Controller interface on the SPI controller, you must write the DMA Control Register (DMACR). Writing a 1 into the TDMAE bit field of DMACR register enables the SPI transmit handshaking interface. Writing a 1 into the RDMAE bit field of the DMACR register enables the SPI receive handshaking interface. †

Slave Interface

The host processor accesses data, control, and status information about the SPI controller through the slave interface. The SPI supports a data bus width of 32 bits. Accesses to the SPI peripheral are described in the following subsections. †

Control and Status Register Access

Control and status registers within the SPI controller are byte-addressable. The maximum width of the control or status register in the SPI controller is 16 bits. Therefore, all read and write operations to the SPI control and status registers require only one access. †

Data Register Access

The data register (DR) within the SPI controller is 16 bits wide in order to remain consistent with the maximum serial transfer size (data frame). A write operation to DR moves data from the slave write data bus into the transmit FIFO buffer. An read operation from DR moves data from the receive FIFO buffer onto the slave readback data bus. †



The DR register in the SPI controller occupies sixty-four 32-bit locations of the memory map to facilitate burst transfers. There are no burst transactions on the system bus itself, but SPI supports bursts on the system interconnect. Writing to any of these address locations has the same effect as pushing the data from the slave write data bus into the transmit FIFO buffer. Reading from any of these locations has the same effect as popping data from the receive FIFO buffer onto the slave readback data bus. The FIFO buffers on the SPI controller are not addressable.

Clocks and Resets

The SPI controller uses the clock and reset signals shown in [Table 19-1](#).

Table 19-1. SPI Controller Clocks and Resets

	Master	Slave
SPI clock	spi_m_clk	l4_main_clk
SPI bit-rate clock	sclk_out	sclk_in
Reset	spim_rst_n	spis_rst_n

SPI Programming Model

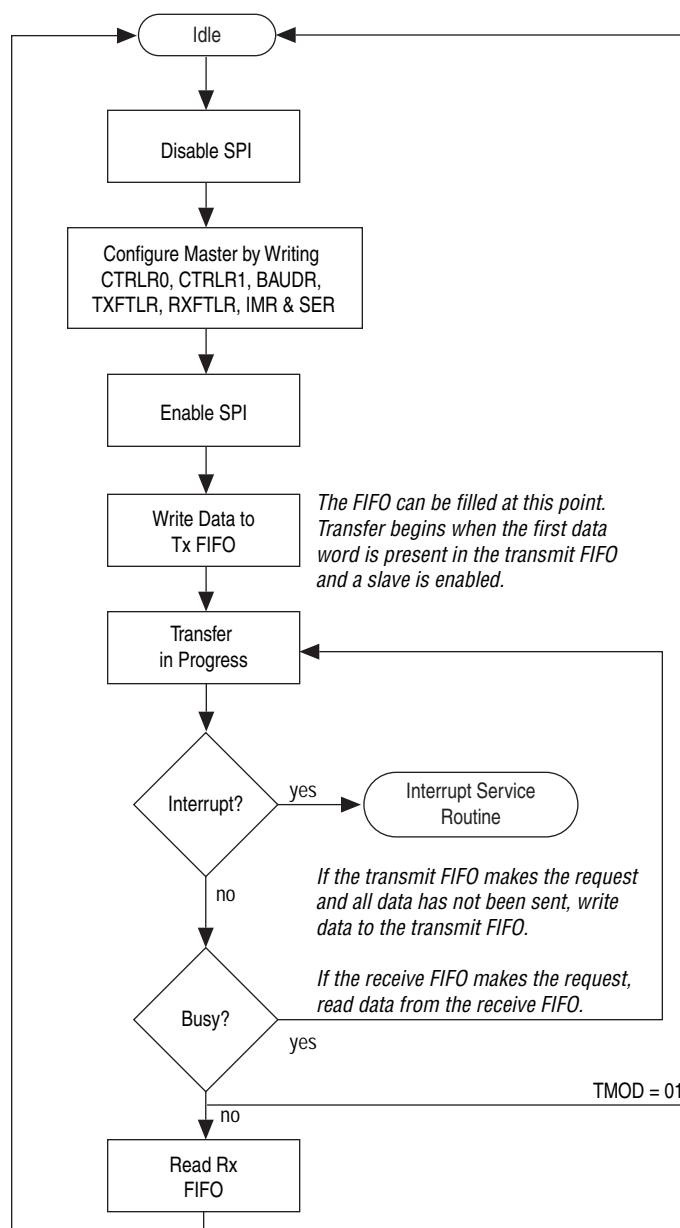
This section describes the programming model for the SPI controller based on the following master and slave transfers:

- Master SPI and SSP Serial Transfers
- Master Microwire Serial Transfers
- Slave SPI and SSP Serial Transfers
- Slave Microwire Serial Transfers
- Software Control for Slave Selection

Master SPI and SSP Serial Transfers

Figure 19-11 shows the software flow for a master SPI or SSP serial transfer.

Figure 19-11. Master SPI or SSP Serial Transfer Software Flow



To complete an SPI or SSP serial transfer from the SPI master, follow these steps:

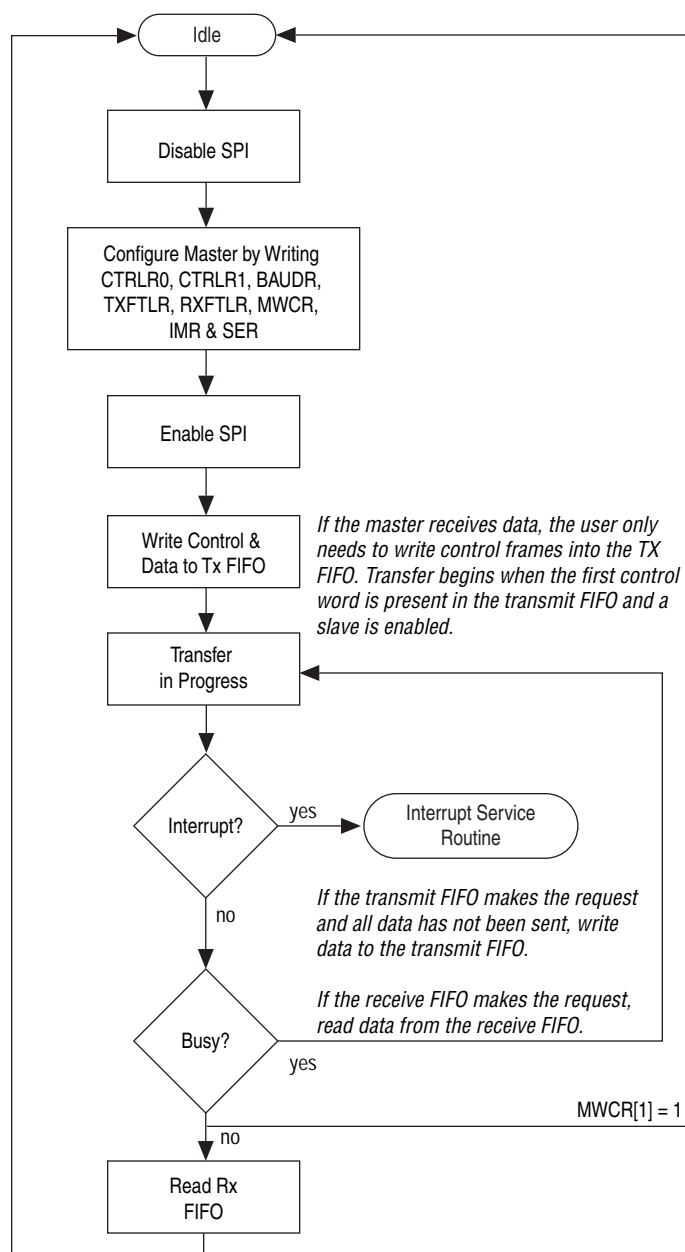
1. If the SPI master is enabled, disable it by writing 0 to the SSI Enable register (SSIENR).

2. Set up the SPI master control registers for the transfer; you can set these transfers in any order.
 - Write Control Register 0 (CTRLR0). For SPI transfers, you must set the serial clock polarity and serial clock phase parameters identical to the target slave device.
 - If the transfer mode is receive only, write Control Register 1 (CTRLR1) with the number of frames in the transfer minus 1. For example, if you want to receive four data frames, write this register with 3.
 - Write the Baud Rate Select Register (BAUDR) to set the baud rate for the transfer.
 - Write the Transmit and Receive FIFO Threshold Level registers (TXFTLR and RXFTLR) to set FIFO buffer threshold levels.
 - Write the IMR register to set up interrupt masks.
 - Write the Slave Enable Register (SER) register here to enable the target slave for selection. If a slave is enabled here, the transfer begins as soon as one valid data entry is present in the transmit FIFO buffer. If no slaves are enabled prior to writing to the Data Register (DR), the transfer does not begin until a slave is enabled.
3. Enable the SPI master by writing 1 to the SSIENR register.
4. Write data for transmission to the target slave into the transmit FIFO buffer (write DR). If no slaves were enabled in the SER register at this point, enable it now to begin the transfer.
5. Poll the BUSY status to wait for the transfer to complete. If a transmit FIFO empty interrupt request is made, write the transmit FIFO buffer (write DR). If a receive FIFO full interrupt request is made, read the receive FIFO buffer (read DR).
6. The shift control logic stops the transfer when the transmit FIFO buffer is empty. If the transfer mode is receive only (TMOD = 2'b10), the shift control logic stops the transfer when the specified number of frames have been received. When the transfer is done, the BUSY status is reset to 0.
7. If the transfer mode is not transmit only (TMOD != 01), read the receive FIFO buffer until it is empty.
8. Disable the SPI master by writing 0 to SSIENR.

Master Microwire Serial Transfers

Figure 19-12 shows the software flow for a Microwire serial transfer.

Figure 19-12. Microwire Serial Transfer Software Flow



To complete a Microwire serial transfer from the SPI master, follow these steps:

1. If the SPI master is enabled, disable it by writing 0 to SSIENR.

2. Set up the SPI control registers for the transfer. You can set these registers in any order.
 - Write `CTRLR0` to set transfer parameters. If the transfer is sequential and the SPI master receives data, write `CTRLR1` with the number of frames in the transfer minus 1. For example, if you want to receive four data frames, write this register with 3.
 - Write `BAUDR` to set the baud rate for the transfer.
 - Write `TXFTLR` and `RXFTLR` to set FIFO buffer threshold levels.
 - Write the `IMR` register to set up interrupt masks.

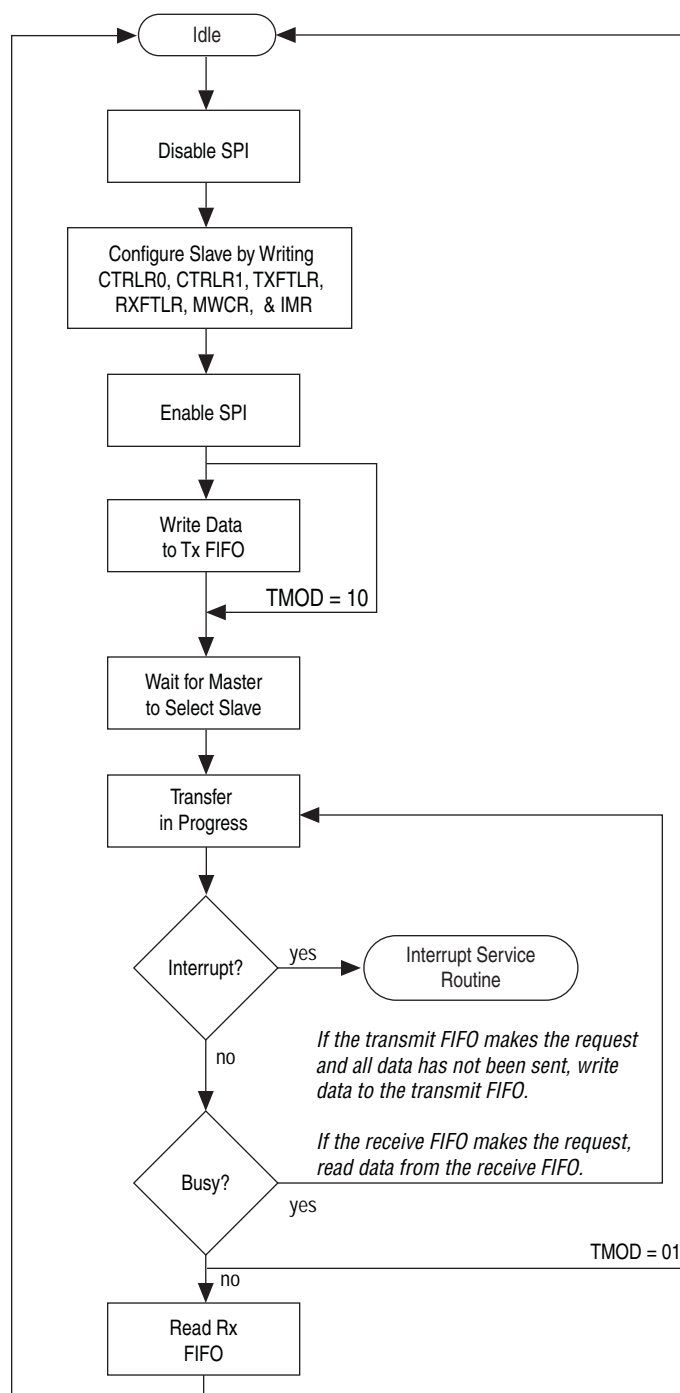
You can write the `SER` register to enable the target slave for selection. If a slave is enabled here, the transfer begins as soon as one valid data entry is present in the transmit FIFO buffer. If no slaves are enabled prior to writing to the `DR` register, the transfer does not begin until a slave is enabled.

3. Enable the SPI master by writing 1 to the `SSIENR` register.
4. If the SPI master transmits data, write the control and data words into the transmit FIFO buffer (write `DR`). If the SPI master receives data, write the control word or words into the transmit FIFO buffer. If no slaves were enabled in the `SER` register at this point, enable now to begin the transfer.
5. Poll the `BUSY` status to wait for the transfer to complete. If a transmit FIFO empty interrupt request is made, write the transmit FIFO buffer (write `DR`). If a receive FIFO full interrupt request is made, read the receive FIFO buffer (read `DR`).
6. The shift control logic stops the transfer when the transmit FIFO buffer is empty. If the transfer mode is sequential and the SPI master receives data, the shift control logic stops the transfer when the specified number of data frames is received. When the transfer is done, the `BUSY` status is reset to 0.
7. If the SPI master receives data, read the receive FIFO buffer until it is empty.
8. Disable the SPI master by writing 0 to `SSIENR`.

Slave SPI and SSP Serial Transfers

Figure 19-13 shows the software flow for a slave SPI or SSP serial transfer.

Figure 19-13. Slave SPI or SSP Serial Transfer Software Flow



To complete a continuous serial transfer from a serial master to the SPI slave, follow these steps:

1. If the SPI slave is enabled, disable it by writing 0 to SSIENR.

2. Set up the SPI control registers for the transfer. You can set these registers in any order.
 - Write CTRLR0 (for SPI transfers, set SCPH and SCPOL identical to the master device).
 - Write TXFTLR and RXFTLR to set FIFO buffer threshold levels.
 - Write the IMR register to set up interrupt masks.
3. Enable the SPI slave by writing 1 to the SSIENR register.
4. If the transfer mode is transmit and receive (TMOD=2'b00) or transmit only (TMOD=2'b01), write data for transmission to the master into the transmit FIFO buffer (write DR). If the transfer mode is receive only (TMOD=2'b10), you need not write data into the transmit FIFO buffer. The current value in the transmit shift register is retransmitted.
5. The SPI slave is now ready for the serial transfer. The transfer begins when a serial-master device selects the SPI slave.
6. When the transfer is underway, the BUSY status can be polled to return the transfer status. If a transmit FIFO empty interrupt request is made, write the transmit FIFO buffer (write DR). If a receive FIFO full interrupt request is made, read the receive FIFO buffer (read DR).
7. The transfer ends when the serial master removes the select input to the SPI slave. When the transfer is completed, the BUSY status is reset to 0.
8. If the transfer mode is not transmit only (TMOD != 01), read the receive FIFO buffer until empty.
9. Disable the SPI slave by writing 0 to SSIENR.

Slave Microwire Serial Transfers

For SPI slave, the Microwire protocol operates in much the same way as the SPI protocol. There is no decode of the control frame by the SPI slave.

Software Control for Slave Selection

When using software to select slave devices, the input select lines from serial slave devices is connected to a single slave select output on the SPI master. The following examples show the software flow for slave selection:

- For SPI master:
 1. If the SPI master is enabled, disable it by writing 0 to SSIENR.
 2. Write CTRLR0 to match the required transfer.
 3. If the transfer is receive only, write the number of frames into CTRLR1.
 4. Write BAUDR to set the transfer baud rate.
 5. Write TXFTLR and RXFTLR to set FIFO buffer threshold levels.
 6. Write IMR register to set interrupt masks.
 7. Write SER register bit[0] to logic '1' to select slave 1 in this example.

8. Write SSIENR register bit[0] to logic '1' to enable SPI master.
- For SPI slave:
9. If the SPI slave is enabled, disable it by writing 0 to SSIENR.
10. Write CTRLR0 to match the required transfer.
11. Write TXFTLR and RXFTLR to set FIFO buffer threshold levels.
12. Write IMR register to set interrupt masks.
13. Write SSIENR register bit[0] to logic '1' to enable SPI slave.
14. If the SPI slave transmits data, write data into TX FIFO buffer. Note all other SPI slaves are disabled (SSIENR = 0) and therefore will not respond to an active level on their `ss_in_n` port.

The FIFO buffer depth (`FIFO_DEPTH`) for both the RX and TX buffers in the SPI controller is 256 entries.

DMA Controller Operation

To enable the DMA controller interface on the SPI controller, you must write the DMA Control Register (`DMACR`). Writing a 1 to the `TDMAE` bit field of `DMACR` register enables the SPI controller transmit handshaking interface. Writing a 1 to the `RDMAE` bit field of the `DMACR` register enables the SPI controller receive handshaking.†



For details about the DMA controller, refer to the *DMA Controller* chapter in volume 3 of the *Cyclone V Device Handbook*.

DMA Operation

For more information about the DMA operation, refer to the ARM DMA chapter.

Transmit FIFO Buffer Underflow

During SPI serial transfers, transmit FIFO buffer requests are made to the DMA Controller whenever the number of entries in the transmit FIFO buffer is less or equal to the value in DMA Transmit Data Level Register (`DMATDLR`); also known as the watermark level. The DMA Controller responds by writing a burst of data to the transmit FIFO buffer, of length specified as DMA burst length.†



For details about the DMA burst length microcode setup, refer to the *DMA Controller* chapter in volume 3 of the *Cyclone V Device Handbook*.

Data should be fetched from the DMA often enough for the transmit FIFO buffer to perform serial transfers continuously, that is, when the FIFO buffer begins to empty, another DMA request should be triggered. Otherwise, the FIFO buffer will run out of data (underflow). To prevent this condition, you must set the watermark level correctly.†

Transmit Watermark Level

Consider the example where the assumption is made: †

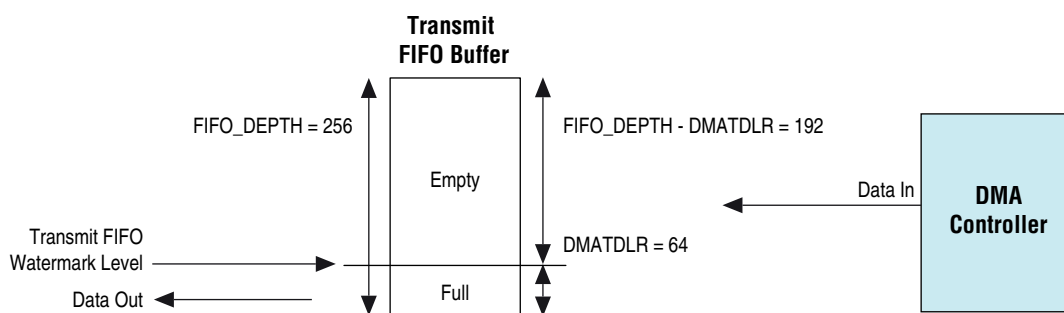
$$\text{DMA burst length} = \text{FIFO_DEPTH} - \text{DMATDLR}$$

Here the number of data items to be transferred in a DMA burst is equal to the empty space in the transmit FIFO buffer. Consider the following two different watermark level settings. †

- Case 1: $\text{DMATDLR} = 64$: †
 - Transmit FIFO watermark level = $\text{DMATDLR} = 64$: †
 - DMA burst length = $\text{FIFO_DEPTH} - \text{DMATDLR} = 192$: †
 - SPI transmit $\text{FIFO_DEPTH} = 256$: †
 - Block transaction size = 960: †

Figure 19-14 shows the transmit FIFO buffer when the watermark level equals 64.

Figure 19-14. Transmit FIFO Watermark Level = 64



The number of burst transactions needed equals the block size divided by the number of data items per burst:

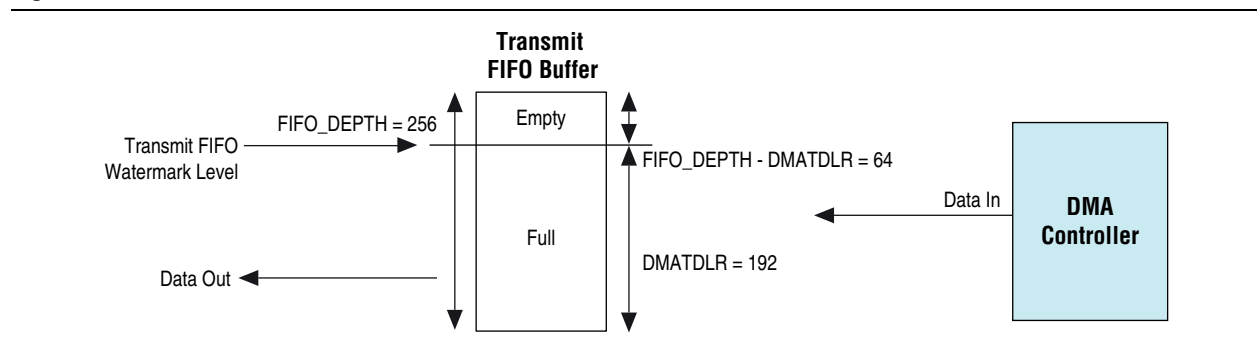
$$\text{Block transaction size} / \text{DMA burst length} = 960 / 192 = 5$$

The number of burst transactions in the DMA block transfer is 5. But the watermark level, DMATDLR , is quite low. Therefore, the probability of transmit underflow is high where the SPI serial transmit line needs to transmit data, but there is no data left in the transmit FIFO buffer. This occurs because the DMA has not had time to service the DMA request before the FIFO buffer becomes empty.

- Case 2: $\text{DMATDLR} = 192$ †
 - Transmit FIFO watermark level = $\text{DMATDLR} = 192$ †
 - DMA burst length = $\text{FIFO_DEPTH} - \text{DMATDLR} = 64$ †
 - SPI transmit $\text{FIFO_DEPTH} = 256$ †
 - Block transaction size = 960 †

Figure 19-15 shows the transmit FIFO buffer when the watermark level equals 192.

Figure 19-15. Transmit FIFO Watermark Level = 192



Number of burst transactions in block: †

Block transaction size/DMA burst length = $960/64 = 15$ †

In this block transfer, there are 15 destination burst transactions in a DMA block transfer. But the watermark level, $DMATDLR$, is high. Therefore, the probability of SPI transmit underflow is low because the DMA controller has plenty of time to service the destination burst transaction request before the SPI transmit FIFO buffer becomes empty. †

Thus, the second case has a lower probability of underflow at the expense of more burst transactions per block. This provides a potentially greater amount of bursts per block and worse bus utilization than the former case. †

Therefore, the goal in choosing a watermark level is to minimize the number of transactions per block, while at the same time keeping the probability of an underflow condition to an acceptable level. In practice, this is a function of the ratio of the rate at which the SPI transmits data to the rate at which the DMA can respond to destination burst requests. †

Transmit FIFO Buffer Overflow

Setting the DMA transaction burst length to a value greater than the watermark level that triggers the DMA request may cause overflow when there is not enough space in the transmit FIFO buffer to service the destination burst request. Therefore, the following equation must be adhered to in order to avoid overflow: †

$$\text{DMA burst length} \leq \text{FIFO_DEPTH} - \text{DMATDLR}$$

In case 2: $DMATDLR = 192$, the amount of space in the transmit FIFO buffer at the time of the burst request is made is equal to the DMA burst length. Thus, the transmit FIFO buffer may be full, but not overflowed, at the completion of the burst transaction. †

Therefore, for optimal operation, DMA burst length should be set at the FIFO buffer level that triggers a transmit DMA request; that is: †

$$\text{DMA burst length} = \text{FIFO_DEPTH} - \text{DMATDLR}$$

Adhering to this equation reduces the number of DMA bursts needed for block transfer, and this in turn improves bus utilization. †



The transmit FIFO buffer will not be full at the end of a DMA burst transfer if the SPI controller has successfully transmitted one data item or more on the serial transmit line during the transfer. †

Receive FIFO Buffer Overflow

During SPI serial transfers, receive FIFO buffer requests are made to the DMA whenever the number of entries in the receive FIFO buffer is at or above the DMA Receive Data Level Register, that is $DMATDLR + 1$. This is known as the watermark level. The DMA responds by fetching a burst of data from the receive FIFO buffer. †

Data should be fetched by the DMA often enough for the receive FIFO buffer to accept serial transfers continuously, that is, when the FIFO buffer begins to fill, another DMA transfer is requested. Otherwise the FIFO buffer will fill with data (overflow). To prevent this condition, the user must set the watermark level correctly. †

Choosing Receive Watermark Level

Similar to choosing the transmit watermark level, the receive watermark level, $DMATDLR + 1$, should be set to minimize the probability of overflow, as shown in Figure 8. It is a trade off between the number of DMA burst transactions required per block versus the probability of an overflow occurring. †

Receive FIFO Buffer Underflow

Setting the source transaction burst length greater than the watermark level can cause underflow where there is not enough data to service the source burst request. Therefore, the following equation must be adhered to avoid underflow: †

$$\text{DMA burst length} = \text{DMATDLR} + 1$$

If the number of data items in the receive FIFO buffer is equal to the source burst length at the time of the burst request is made, the receive FIFO buffer may be emptied, but not underflowed, at the completion of the burst transaction. For optimal operation, DMA burst length should be set at the watermark level, $DMATDLR + 1$. †

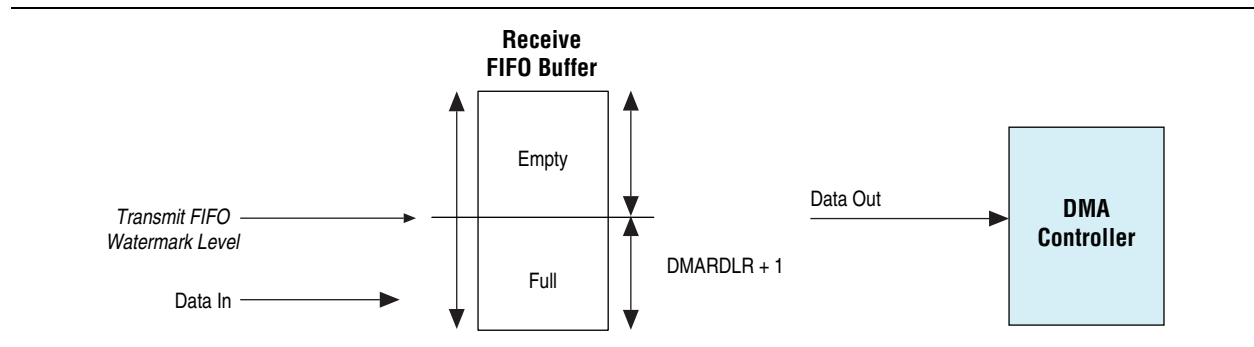
Adhering to this equation reduces the number of DMA bursts in a block transfer, which in turn can improve bus utilization. †



The receive FIFO buffer will not be empty at the end of the source burst transaction if the SPI controller has successfully received one data item or more on the serial receive line during the burst. †

Figure 19-16 shows the receive FIFO buffer.

Figure 19-16. Receive FIFO Buffer



SPI Controller Address Map and Register Definitions

The address map and register definitions reside in [hps.html](#) file that accompanies this handbook volume. Click the link to open the file.

To view the module description and base address, scroll to and click the link for any of the following module instances:

- **spis0**
- **spis1**
- **spim0**
- **spim1**

To then view the register and field descriptions, scroll to and click the register names. The register addresses are offsets relative to the base address of each module instance.

The base addresses of all modules are also listed in the *Introduction to the Hard Processor System* chapter in volume 3 of the *Cyclone V Device Handbook*.

Document Revision History

Table 19-2 shows the revision history for this document.

Table 19-2. Document Revision History

Date	Version	Changes
November 2012	1.2	Minor updates.
May 2012	1.1	Added programming model, address map and register definitions, clocks, and reset sections.
January 2012	1.0	Initial release.

The I²C controller provides support for a communication link between integrated circuits on a board. It is a simple two-wire bus which consists of a serial data line (SDA) and a serial clock (SCL) for use in applications such as temperature sensors and voltage level translators to EEPROMs, A/D and D/A converters, CODECs, and many types of microprocessors. †

The hard processor system (HPS) provides four I²C controllers to enable system software to communicate serially with I²C buses. Each I²C controller can operate in master or slave mode, and support standard mode of up to 100 kilobits per second (Kbps) or fast mode of up to 400 Kbps. These I²C controllers are instances of the Synopsys® DesignWare® APB I²C (DW_apb_i2c) controller.



Each I²C controller must be programmed to operate in either master or slave mode only. Operating as a master and slave simultaneously is not supported. †

Features of the I²C Controller

The I²C controller has the following features:

- Maximum clock speed of up to 400 Kbps
- One of the following I²C operations:
 - A master in an I²C system and programmed only as a master †
 - A slave in an I²C system and programmed only as a slave †
- 7- or 10-bit addressing †
- Mixed read and write combined-format transactions in both 7-bit and 10-bit addressing mode †
- Bulk transmit mode †
- Transmit and receive buffers †
- Handles bit and byte waiting at all bus speeds †
- DMA handshaking interface †

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†Paragraphs marked with the dagger (†) symbol are Synopsys Proprietary. Used with permission.

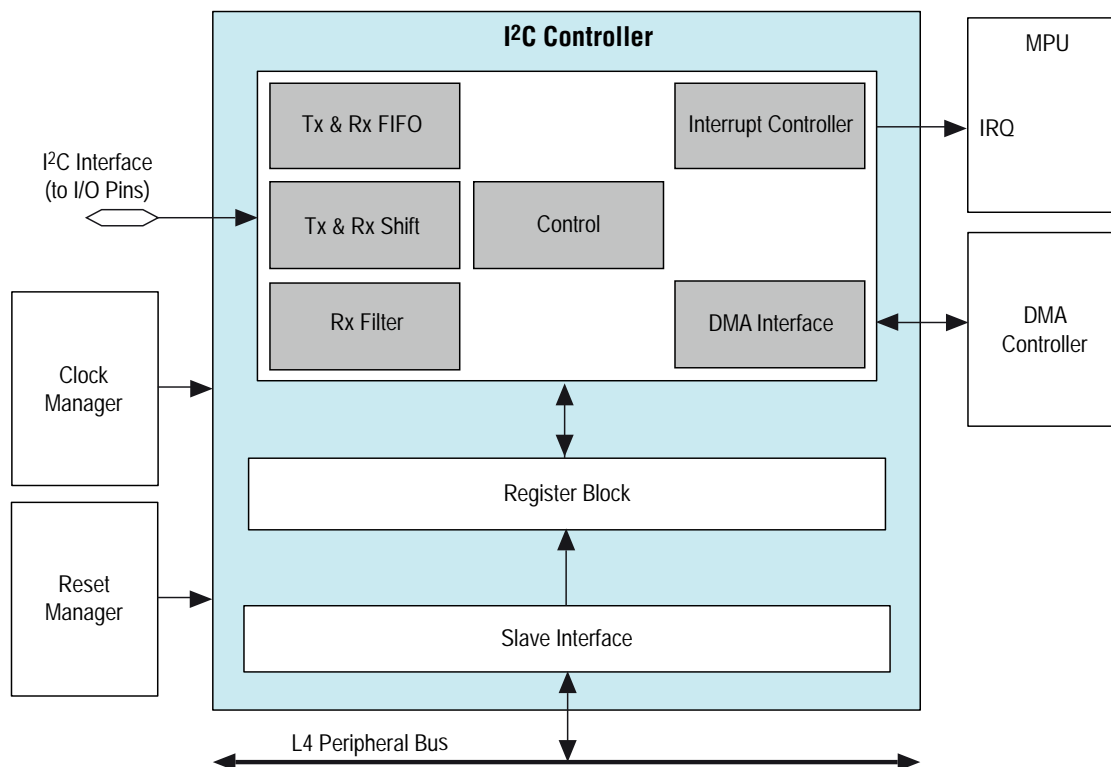


I²C Controller Block Diagram and System Integration

The I²C controller consists of a slave interface, an I²C interface, and FIFO logic to buffer data between the two interfaces. †

The host processor accesses data, control, and status information about the I²C controller through a 32-bit slave interface. Figure 20-1 shows the I²C controller block diagram.

Figure 20-1. I²C Controller Block Diagram



The I²C controller consists of the following modules and interfaces:

- Slave interface for control and status register (CSR) accesses and DMA transfers, allowing a master to access the CSRs and the DMA to read or write data directly.
- Two FIFO buffers for transmit and receive data, which hold the Rx FIFO and Tx FIFO buffer register banks and controllers, along with their status levels. †
- Shift logic for parallel-to-serial and serial-to-parallel conversion
 - Rx shift – Receives data into the design and extracts it in byte format. †
 - Tx shift – Presents data supplied by CPU for transfer on the I²C bus. †
- Control logic responsible for implementing the I²C protocol.
- DMA interface that generates handshaking signals to the DMA controller in order to automate the data transfer without CPU intervention. †

- Interrupt controller that generates raw interrupt and interrupt flags, allowing them to be set and cleared. †
- Receive filter for detecting events, such as start and stop conditions, in the bus; for example, start, stop and arbitration lost. †

Functional Description of the I²C Controller

This section describes the functional operation of the I²C controller.

Feature Usage

The I²C controller can operate in standard mode (with data rates 0 to 100 Kbps) or fast mode (with data rates less than or equal to 400 Kbps). Additionally, fast mode devices are downward compatible. For instance, fast mode devices can communicate with standard mode devices in 0 to 100 Kbps I²C bus system. However, standard mode devices are not upward compatible and should not be incorporated in a fast-mode I²C bus system as they cannot follow the higher transfer rate and therefore unpredictable states would occur. †

You can attach any I²C controller to an I²C-bus and every device can talk with any master, passing information back and forth. There needs to be at least one master (such as a microcontroller or DSP) on the bus and there can be multiple masters, which require them to arbitrate for ownership. Multiple masters and arbitration are explained later in this chapter. †

Behavior

You can control the I²C controller via software to be either mode:

- An I²C master only, communicating with other I²C slaves; OR
- An I²C slave only, communicating with one or more I²C masters.

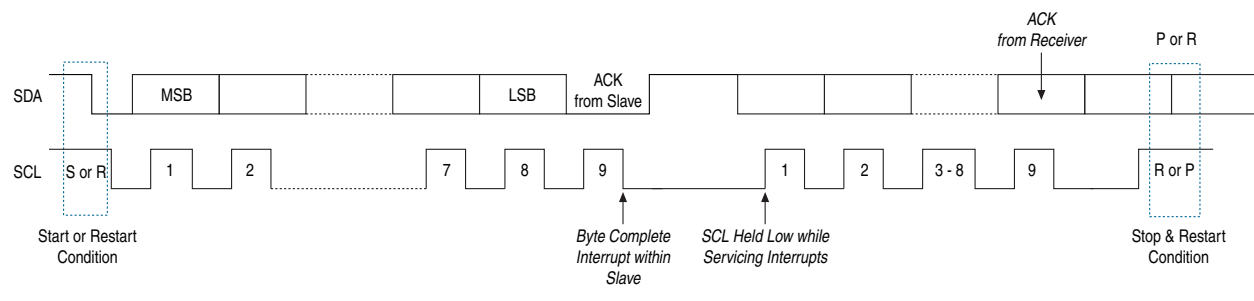
The master is responsible for generating the clock and controlling the transfer of data. The slave is responsible for either transmitting or receiving data to/from the master. The acknowledgement of data is sent by the device that is receiving data, which can be either a master or a slave. As mentioned previously, the I²C protocol also allows multiple masters to reside on the I²C bus and uses an arbitration procedure to determine bus ownership. †

Each slave has a unique address that is determined by the system designer. When a master wants to communicate with a slave, the master transmits a START/RESTART condition that is then followed by the slave's address and a control bit (R/W) to determine if the master wants to transmit data or receive data from the slave. The slave then sends an acknowledge (ACK) pulse after the address. †

If the master (master-transmitter) is writing to the slave (slave-receiver), the receiver receives one byte of data. This transaction continues until the master terminates the transmission with a STOP condition. If the master is reading from a slave (master-receiver), the slave transmits (slave-transmitter) a byte of data to the master, and the master then acknowledges the transaction with an ACK pulse. This transaction continues until the master terminates the transmission by not acknowledging (NACK) the transaction after the last byte is received, and then the master issues a STOP condition or addresses another slave after issuing a RESTART condition. †

Figure 20-2 illustrates the data transfer behavior on the I²C bus.

Figure 20-2. Data transfer on the I²C Bus †



The I²C controller is a synchronous serial interface. The SDA line is a bidirectional signal and changes only while the SCL line is low, except for STOP, START, and RESTART conditions. The output drivers are open-drain or open-collector to perform wire-AND functions on the bus. The maximum number of devices on the bus is limited by only the maximum capacitance specification of 400 pF. Data is transmitted in byte packages. †

START and STOP Generation

When operating as a master, putting data into the transmit FIFO causes the I²C controller to generate a START condition on the I²C bus. Allowing the transmit FIFO to empty causes the I²C controller to generate a STOP condition on the I²C bus. †

When operating as a slave, the I²C controller does not generate START and STOP conditions, as per the protocol. However, if a read request is made to the I²C controller, it holds the SCL line low until read data has been supplied to it. This stalls the I²C bus until read data is provided to the slave I²C controller, or the I²C controller slave is disabled by writing a 0 to IC_ENABLE register. †

Combined Formats

The I²C controller supports mixed read and write combined format transactions in both 7-bit and 10-bit addressing modes. †

The I²C controller does not support mixed address and mixed address format—that is, a 7-bit address transaction followed by a 10-bit address transaction or vice versa—combined format transactions. †

To initiate combined format transfers, the IC_RESTART_EN bit in the IC_CON register should be set to 1. With this value set and operating as a master, when the I²C controller completes an I²C transfer, it checks the transmit FIFO and executes the next transfer. If the direction of this transfer differs from the previous transfer, the combined format is used to issue the transfer. If the transmit FIFO is empty when the current I²C transfer completes, a STOP is issued and the next transfer is issued following a START condition. †

Protocol Details

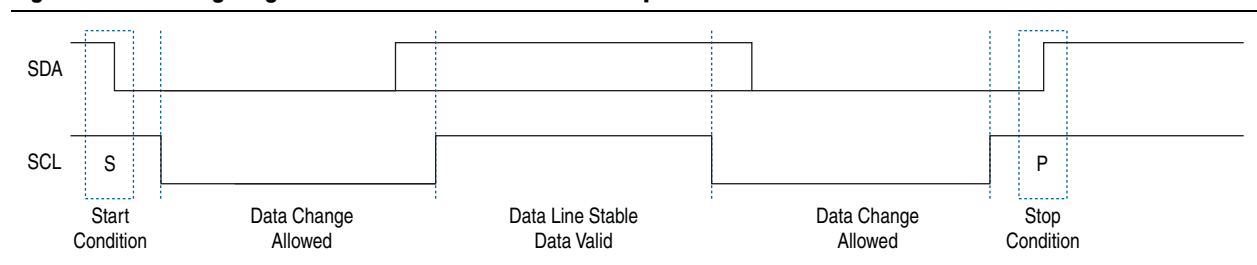
This section describes the I²C controller protocols.

START and STOP Conditions

When the bus is idle, both the SCL and SDA signals are pulled high through pull-up resistors on the bus. When the master wants to start a transmission on the bus, the master issues a START condition. This is defined to be a high-to-low transition of the SDA signal while SCL is 1. When the master wants to terminate the transmission, the master issues a STOP condition. This is defined to be a low-to-high transition of the SDA line while SCL is 1. †

Figure 20–3 shows the timing of the START and STOP conditions. When data is being transmitted on the bus, the SDA line must be stable when SCL is 1. †

Figure 20–3. Timing Diagram for START and STOP Condition †





The signal transitions for the START or STOP condition, as shown in Figure 20-3, reflect those observed at the output signals of the master driving the I²C bus. Care should be taken when observing the SDA or SCL signals at the input signals of the slave(s), because unequal line delays may result in an incorrect SDA or SCL timing relationship. †

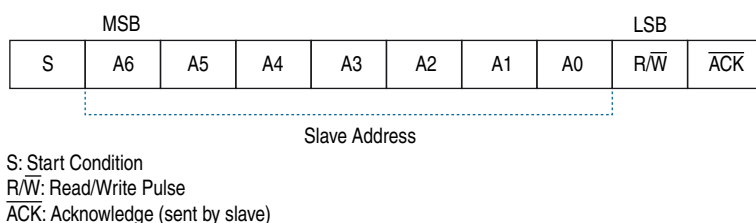
Addressing Slave Protocol

There are two address formats: the 7-bit address format and the 10-bit address format.

7-Bit Address Format

During the 7-bit address format, the first seven bits (bits 7:1) of the first byte set the slave address and the LSB bit (bit 0) is the R/W bit as shown in Figure 20-4. When bit 0 (R/W) is set to 0, the master writes to the slave. When bit 0 (R/W) is set to 1, the master reads from the slave. †

Figure 20-4. 7-bit Address Format †



10-Bit Address Format

During 10-bit addressing, two bytes are transferred to set the 10-bit address. The transfer of the first byte contains the following bit definition. The first five bits (bits 7:3) notify the slaves that this is a 10-bit transfer followed by the next two bits (bits 2:1), which set the slaves address bits 9:8, and the LSB bit (bit 0) is the R/W bit. The second byte transferred sets bits 7:0 of the slave address. Figure 20-5 shows the 10-bit address format. †

Figure 20-5. 10-Bit Address Format †

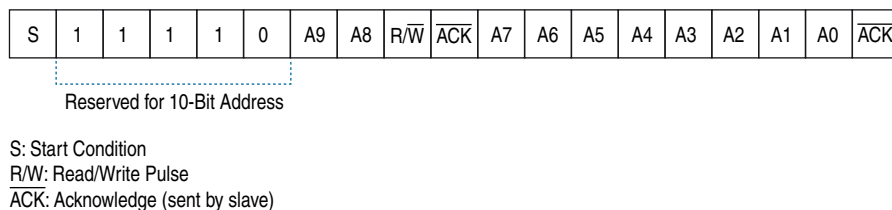


Table 20-1 defines the special purpose and reserved first byte addresses. †

Table 20-1. I²C Definition of Bits in First Byte †

Slave Address	R/W Bit	Description
0000 000	0	General call address. The I ² C controller places the data in the receive buffer and issues a general call interrupt.
0000 000	1	START byte. For more details, refer to “START BYTE Transfer Protocol” on page 20-9
0000 001	X	CBUS address. The I ² C controller ignores these accesses.
0000 010	X	Reserved
0000 011	X	Reserved
0000 1XX	X	Unused
1111 1XX	X	Reserved
1111 0XX	X	10-bit slave addressing.
Note to Table 20-1: (1) ‘X’ indicates do not care.		

Transmitting and Receiving Protocol

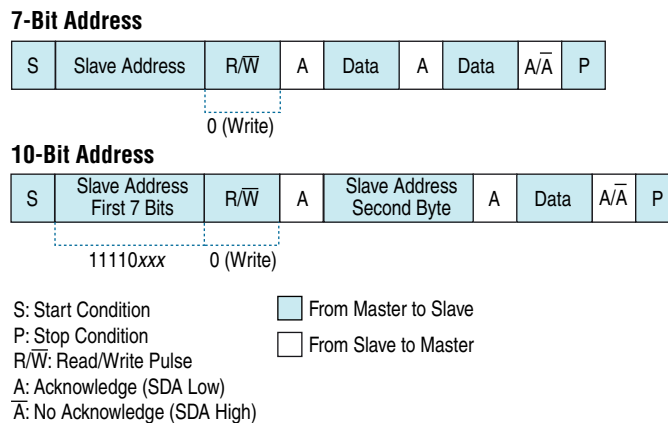
The master can initiate data transmission and reception to or from the bus, acting as either a master-transmitter or master-receiver. A slave responds to requests from the master to either transmit data or receive data to or from the bus, acting as either a slave-transmitter or slave-receiver, respectively. †

Master-Transmitter and Slave-Receiver

All data is transmitted in byte format, with no limit on the number of bytes transferred per data transfer. After the master sends the address and R/W bit or the master transmits a byte of data to the slave, the slave-receiver must respond with the acknowledge signal (ACK). When a slave-receiver does not respond with an ACK pulse, the master aborts the transfer by issuing a STOP condition. The slave must leave the SDA line high so that the master can abort the transfer. †

If the master-transmitter is transmitting data as shown in Figure 20-6, then the slave-receiver responds to the master-transmitter with an ACK pulse after every byte of data is received. †

Figure 20-6. Master-Transmitter Protocol †



Master-Receiver and Slave-Transmitter

If the master is receiving data as shown in Figure 20-7, then the master responds to the slave-transmitter with an ACK pulse after a byte of data has been received, except for the last byte. This is the way the master-receiver notifies the slave-transmitter that this is the last byte. The slave-transmitter relinquishes the SDA line after detecting the No Acknowledge (NACK) bit so that the master can issue a STOP condition. †

When a master does not want to relinquish the bus with a STOP condition, the master can issue a RESTART condition. This is identical to a START condition except it occurs after the ACK pulse. Operating in master mode, the I²C controller can then communicate with the same slave using a transfer of a different direction. For a description of the combined format transactions that the I²C controller supports, refer to “Combined Formats” on page 20-5. †


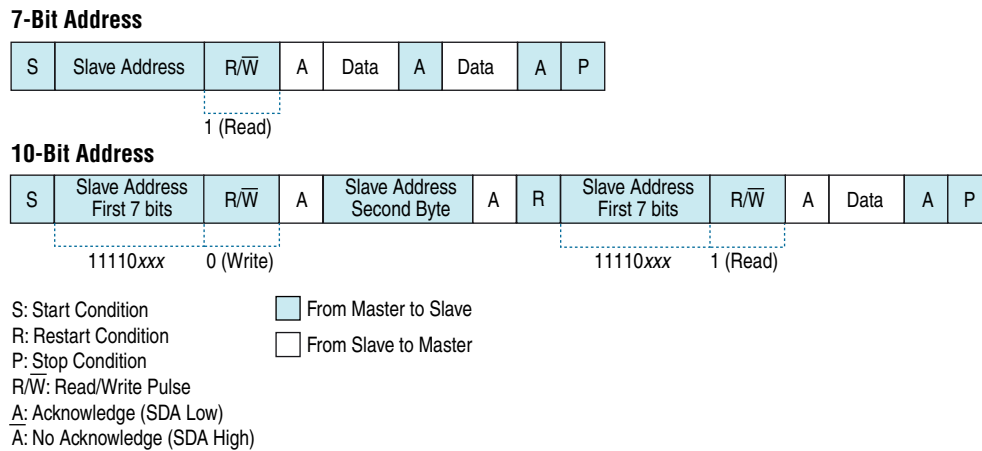
 The I²C controller must be inactive on the serial port (I2C_DYNAMIC_TAR_UPDATE = 1) before the target slave address register, IC_TAR can be reprogrammed. †

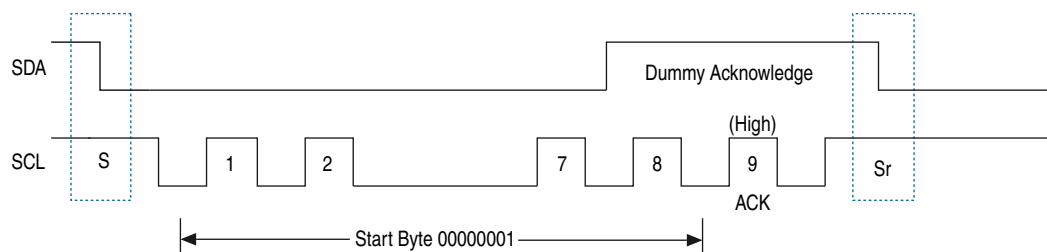
Figure 20-7. Master-Receiver Protocol †



START BYTE Transfer Protocol

The START BYTE transfer protocol is set up for systems that do not have an on-board dedicated I²C hardware module. When the I²C controller is set as a slave, it always samples the I²C bus at the highest speed supported so that it never requires a START BYTE transfer. However, when I²C controller is set as a master, it supports the generation of START BYTE transfers at the beginning of every transfer in case a slave device requires it. This protocol consists of seven zeros being transmitted followed by a 1, as illustrated in [Figure 20-8](#). This allows the processor that is polling the bus to under-sample the address phase until the microcontroller detects a 0. Once the microcontroller detects a 0, it switches from the under sampling rate to the correct rate of the master. †

Figure 20-8. START BYTE Transfer †



The START BYTE has the following procedure: †

1. Master generates a START condition. †
2. Master transmits the START byte (0000 0001). †
3. Master transmits the ACK clock pulse. (Present only to conform with the byte handling format used on the bus) †
4. No slave sets the ACK signal to 0. †

5. Master generates a RESTART (R) condition. †

A hardware receiver does not respond to the START BYTE because it is a reserved address and resets after the RESTART condition is generated. †

Multiple Master Arbitration

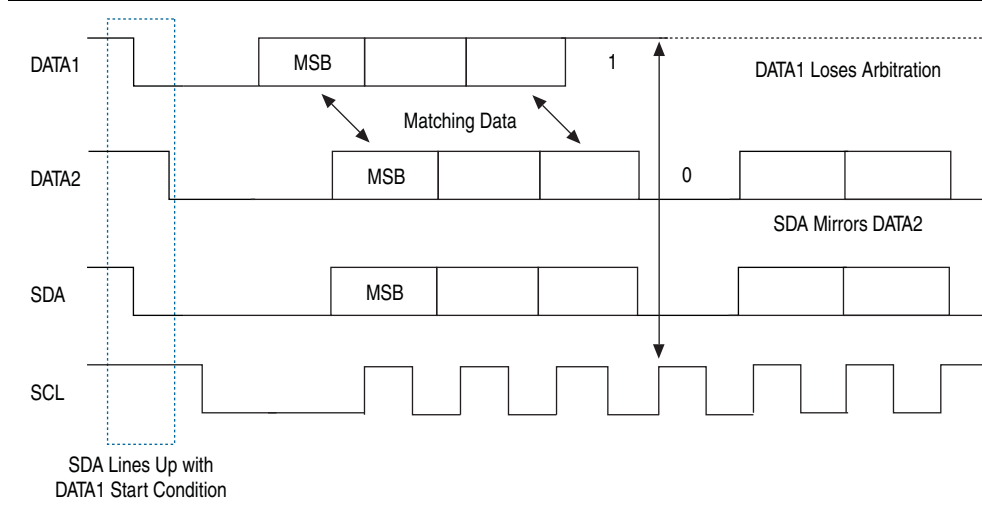
The I²C controller bus protocol allows multiple masters to reside on the same bus. If there are two masters on the same I²C-bus, there is an arbitration procedure if both try to take control of the bus at the same time by simultaneously generating a START condition. Once a master (for example, a microcontroller) has control of the bus, no other master can take control until the first master sends a STOP condition and places the bus in an idle state. †

Arbitration takes place on the SDA line, while the SCL line is 1. The master, which transmits a 1 while the other master transmits 0, loses arbitration and turns off its data output stage. The master that lost arbitration can continue to generate clocks until the end of the byte transfer. If both masters are addressing the same slave device, the arbitration could go into the data phase. †

Upon detecting that it has lost arbitration to another master, the I²C controller stops generating SCL. †

Figure 20-9 illustrates the timing of when two masters are arbitrating on the bus.

Figure 20-9. Multiple Master Arbitration †



The bus control is determined by address or master code and data sent by competing masters, so there is no central master nor any order of priority on the bus. †

Arbitration is not allowed between the following conditions: †

- A RESTART condition and a data bit †
- A STOP condition and a data bit †
- A RESTART condition and a STOP condition †

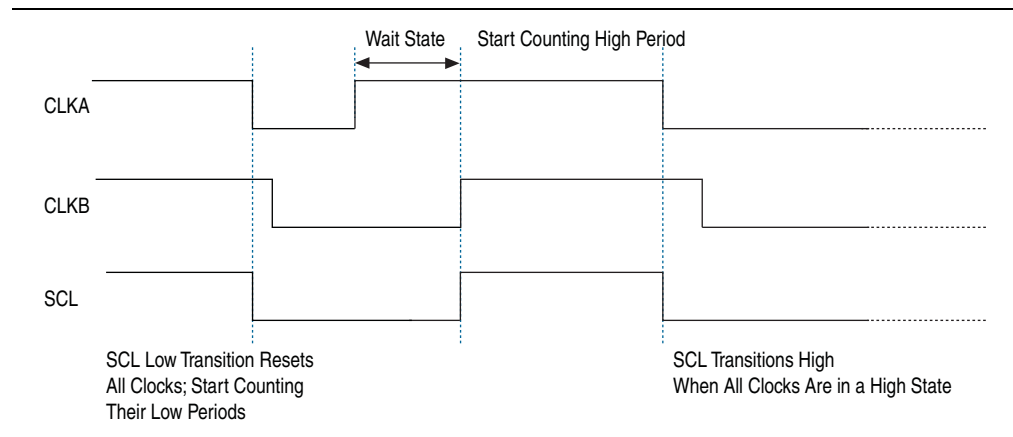
Slaves are not involved in the arbitration process. †

Clock Synchronization

When two or more masters try to transfer information on the bus at the same time, they must arbitrate and synchronize the SCL clock. All masters generate their own clock to transfer messages. Data is valid only during the high period of SCL clock. Clock synchronization is performed using the wired-AND connection to the SCL signal. When the master transitions the SCL clock to 0, the master starts counting the low time of the SCL clock and transitions the SCL clock signal to 1 at the beginning of the next clock period. However, if another master is holding the SCL line to 0, then the master goes into a HIGH wait state until the SCL clock line transitions to 1. †

All masters then count off their high time, and the master with the shortest high time transitions the SCL line to 0. The masters then counts out their low time and the one with the longest low time forces the other master into a HIGH wait state. Therefore, a synchronized SCL clock is generated, which is illustrated in [Figure 20-10](#). Optionally, slaves may hold the SCL line low to slow down the timing on the I²C bus. †

Figure 20-10. Multiple Master Clock Synchronization †



Clock Frequency Configuration

When you configure the I²C controller as a master, the SCL count registers must be set before any I²C bus transaction can take place in order to ensure proper I/O timing. † There are four SCL count registers:

- Standard speed I²C clock SCL high count, IC_SS_SCL_HCNT †
- Standard speed I²C clock SCL low count, IC_SS_SCL_LCNT †
- Fast speed I²C clock SCL high count, IC_FS_SCL_HCNT †
- Fast speed I²C clock SCL low count, IC_FS_SCL_LCNT †



It is not necessary to program any of the SCL count registers if the I²C controller is enabled to operate only as an I²C slave, since these registers are used only to determine the SCL timing requirements for operation as an I²C master. †

Minimum High and Low Counts

When the I²C controller operates as an I²C master in both transmit and receive transfers, the minimum value that can be programmed in the SCL low count registers is 8 while the minimum value allowed for the SCL high count registers is 6. †

The minimum value of 8 for the low count registers is due to the time required for the I²C controller to drive SDA after a negative edge of SCL. The minimum value of 6 for the high count register is due to the time required for the I²C controller to sample SDA during the high period of SCL. †

The I²C controller adds one cycle to the low count register values in order to generate the low period of the SCL clock.

The I²C controller adds seven cycles to the high count register values in order to generate the high period of the SCL clock. This is due to the following factors: †

- The digital filtering applied to the SCL line incurs a delay of four 14_sp_clk cycles. This filtering includes metastability removal and a 2-out-of-3 majority vote processing on SDA and SCL edges. †
- Whenever SCL is driven 1 to 0 by the I²C controller—that is, completing the SCL high time—an internal logic latency of three 14_sp_clk cycles incurs. †

Consequently, the minimum SCL low time of which the I²C controller is capable is nine (9) 14_sp_clk periods (8+1), while the minimum SCL high time is thirteen (13) 14_sp_clk periods (6+1+3+3). †

Calculating High and Low Counts

The calculations below show an example of how to calculate SCL high and low counts for each speed mode in the I²C controller.

The equation to calculate the proper number of `l4_sp_clk` clock pulses required for setting the proper SCL clocks high and low times is as follows: †

Equation 20-1.

```
IC_HCNT = ceil(MIN_SCL_HIGHTime*OSCFREQ)
```

```
IC_LCNT = ceil(MIN_SCL_LOWtime*OSCFREQ)
```

```
MIN_SCL_HIGHTime = minimum high period
```

```
MIN_SCL_HIGHTime =
```

```
4000 ns for 100 kbps
```

```
600 ns for 400 kbps
```

```
60 ns for 3.4 Mbs, bus loading = 100pF
```

```
160 ns for 3.4 Mbs, bus loading = 400pF
```

```
MIN_SCL_LOWtime = minimum low period
```

```
MIN_SCL_LOWtime =
```

```
4700 ns for 100 kbps
```

```
1300 ns for 400 kbps
```

```
120 ns for 3.4Mbs, bus loading = 100pF
```

```
320 ns for 3.4Mbs, bus loading = 400pF
```

```
OSCFREQ = l4_sp_clk clock frequency (Hz)
```

For example:

```
OSCFREQ = 100 MHz
```

```
I2Cmode = fast, 400 kbps
```

```
MIN_SCL_HIGHTime = 600 ns
```

```
MIN_SCL_LOWtime = 1300 ns
```

```
IC_HCNT = ceil(600 ns * 100 MHz) IC_HCNTSCL PERIOD = 60
```

```
IC_LCNT = ceil(1300 ns * 100 MHz) IC_LCNTSCL PERIOD = 130
```

```
Actual MIN_SCL_HIGHTime = 60*(1/100 MHz) = 600 ns
```

```
Actual MIN_SCL_LOWtime = 130*(1/100 MHz) = 1300 ns †
```

SDA Hold Time

The I²C protocol specification requires 300 ns of hold time on the SDA signal in standard and fast speed modes. Board delays on the SCL and SDA signals can mean that the hold time requirement is met at the I²C master, but not at the I²C slave (or vice-versa). As each application encounters differing board delays, the I²C controller contains a software programmable register, `IC_SDA_HOLD`, to enable dynamic adjustment of the SDA hold time. †

DMA Controller Interface

The I²C controller supports DMA signaling to indicate when data is ready to be read or when the transmit FIFO needs data. This support requires 2 DMA channels, one for transmit data and one for receive data. The I²C controller supports both single and burst DMA transfers. System software can choose the DMA burst mode by programming an appropriate value into the threshold registers. The recommended setting of the FIFO threshold register value is half full.

To enable the DMA controller interface on the I²C controller, you must write to the DMA control register (DMACR) bits. Writing a 1 into the TDMAE bit field of DMACR register enables the I²C controller transmit handshaking interface. Writing a 1 into the RDMAE bit field of the DMACR register enables the I²C controller receive handshaking interface. †



For details about the DMA controller, refer to the *DMA Controller* chapter in volume 3 of the *Cyclone V Device Handbook*.

Clocks

Each I²C controller is connected to the 14_sp_clk clock, which clocks transfers in standard and fast mode. The clock input is driven by the clock manager.



For more information, refer to the *Clock Manager* chapter in volume 3 of the *Cyclone V Device Handbook*.

Resets

Each I²C controller has a separate reset signal. The reset manager drives the signals on a cold or warm reset.



For more information, refer to the *Reset Manager* chapter in volume 3 of the *Cyclone V Device Handbook*.

Interface Pins

All instances of the I²C controller connect to external pins through pin multiplexers. Pin multiplexing allows all instances to function simultaneously and independently. The pins must be connected to a pull-up resistors and the I²C bus capacitance cannot exceed 400 pF.

Table 20-2 shows I/O pin use of the I²C controller interface.

Table 20-2. I²C Controller Interface Pins

Pin Name	Signal Width	Direction	Description
SCL	1 bit	Bidirectional	Serial clock
SDA	1 bit	Bidirectional	Serial data

I²C Controller Programming Model

This section describes the programming model for the I²C controllers based on the two master and slave operation modes. †



Each I²C controller should be set to operate only as an I²C master or as an I²C slave, never both simultaneously. Ensure that bit 6 (IC_SLAVE_DISABLE) and 0 (IC_MASTER_MODE) of the IC_CON register are never set to 0 and 1, respectively. †

Slave Mode Operation

This section discusses slave mode procedures. †

Initial Configuration

To use the I²C controller as a slave, perform the following steps: †

1. Disable the I²C controller by writing a 0 to bit 0 of the IC_ENABLE register. †
2. Write to the IC_SAR register (bits 9:0) to set the slave address. This is the address to which the I²C controller responds. †



The reset value for the I²C controller slave address is 0x55. If you are using 0x55 as the slave address, you can safely skip this step.

3. Write to the IC_CON register to specify which type of addressing is supported (7- or 10-bit by setting bit 3). Enable the I²C controller in slave-only mode by writing a 0 into bit 6 (IC_SLAVE_DISABLE) and a 0 to bit 0 (MASTER_MODE). †



Slaves and masters do not have to be programmed with the same type of addressing 7- or 10-bit address. For instance, a slave can be programmed with 7-bit addressing and a master with 10-bit addressing, and vice versa. †

4. Enable the I²C controller by writing a 1 in bit 0 of the IC_ENABLE register. †

Slave-Transmitter Operation for a Single Byte

When another I²C master device on the bus addresses the I²C controller and requests data, the I²C controller acts as a slave-transmitter and the following steps occur: †

1. The other I²C master device initiates an I²C transfer with an address that matches the slave address in the IC_SAR register of the I²C controller †
2. The I²C controller acknowledges the sent address and recognizes the direction of the transfer to indicate that it is acting as a slave-transmitter. †

3. The I²C controller asserts the RD_REQ interrupt (bit 5 of the IC_RAW_INTR_STAT register) and waits for software to respond. †

If the RD_REQ interrupt has been masked, due to bit 5 of the IC_INTR_MASK register (M_RD_REQ bit field) being set to 0, then it is recommended that you instruct the CPU to perform periodic reads of the IC_RAW_INTR_STAT register. †

- a. Reads that indicate bit 5 of the IC_RAW_INTR_STAT register (R_RD_REQ bit field) being set to 1 must be treated as the equivalent of the RD_REQ interrupt being asserted. †
- b. Software must then act to satisfy the I²C transfer. †
- c. The timing interval used should be in the order of 10 times the fastest SCL clock period the I²C controller can handle. For example, for 400 Kbps, the timing interval is 25 us. †



The value of 10 is recommended here because this is approximately the amount of time required for a single byte of data transferred on the I²C bus. †

4. If there is any data remaining in the TX FIFO before receiving the read request, the I²C controller asserts a TX_ABRT interrupt (bit 6 of the IC_RAW_INTR_STAT register) to flush the old data from the TX FIFO. †



Because the I²C controller's TX FIFO is forced into a flushed/reset state whenever a TX_ABRT event occurs, it is necessary for software to release the I²C controller from this state by reading the IC_CLR_TX_ABRT register before attempting to write into the TX FIFO. For more information, refer to the IC_RAW_INTR_STAT register description in the register map. †

If the TX_ABRT interrupt has been masked, due to of IC_INTR_MASK[6] register (M_TX_ABRT bit field) being set to 0, then it is recommended that the CPU performs periodic reads of the IC_RAW_INTR_STAT register. †

- a. Reads that indicate bit 6 (R_TX_ABRT) being set to 1 must be treated as the equivalent of the TX_ABRT interrupt being asserted. †
- b. There is no further action required from software. †
- c. The timing interval used should be similar to that described in the previous step for the IC_RAW_INTR_STAT[5] register. †
5. Software writes to the DAT bits of the IC_DATA_CMD register with the data to be written and writes a 0 in bit 8. †
6. Software must clear the RD_REQ and TX_ABRT interrupts (bits 5 and 6, respectively) of the IC_RAW_INTR_STAT register before proceeding. †

If the RD_REQ and/or TX_ABRT interrupts have been masked, then clearing of the IC_RAW_INTR_STAT register will have already been performed when either the R_RD_REQ or R_TX_ABRT bit has been read as 1. †

7. The I²C controller transmits the byte. †
8. The master may hold the I²C bus by issuing a RESTART condition or release the bus by issuing a STOP condition. †

Slave-Receiver Operation for a Single Byte

When another I²C master device on the bus addresses the I²C controller and is sending data, the I²C controller acts as a slave-receiver and the following steps occur:†

1. The other I²C master device initiates an I²C transfer with an address that matches the I²C controller's slave address in the IC_SAR register. †
2. The I²C controller acknowledges the sent address and recognizes the direction of the transfer to indicate that the I²C controller is acting as a slave-receiver. †
3. I²C controller receives the transmitted byte and places it in the receive buffer. †



If the RX FIFO is completely filled with data when a byte is pushed, then an overflow occurs and the I²C controller continues with subsequent I²C transfers. Because a NACK is not generated, software must recognize the overflow when indicated by the I²C controller (by the R_RX_OVER bit in the IC_INTR_STAT register) and take appropriate actions to recover from lost data. Hence, there is a real time constraint on software to service the RX FIFO before the latter overflow as there is no way to reapply pressure to the remote transmitting master. †

4. I²C controller asserts the RX_FULL interrupt (IC_RAW_INTR_STAT[2] register). †

If the RX_FULL interrupt has been masked, due to setting IC_INTR_MASK[2] register to 0 or setting IC_TX_TL to a value larger than 0, then it is recommended that the CPU does periodic reads of the IC_STATUS register. Reads of the IC_STATUS register, with bit 3 (RFNE) set at 1, must then be treated by software as the equivalent of the RX_FULL interrupt being asserted. †

5. Software may read the byte from the IC_DATA_CMD register (bits 7:0). †
6. The other master device may hold the I²C bus by issuing a RESTART condition or release the bus by issuing a STOP condition. †

Slave-Transfer Operation for Bulk Transfers

In the standard I²C protocol, all transactions are single byte transactions and the programmer responds to a remote master read request by writing one byte into the slave's TX FIFO. When a slave (slave-transmitter) is issued with a read request (RD_REQ) from the remote master (master-receiver), at a minimum there should be at least one entry placed into the slave-transmitter's TX FIFO. The I²C controller is designed to handle more data in the TX FIFO so that subsequent read requests can receive that data without raising an interrupt to request more data. Ultimately, this eliminates the possibility of significant latencies being incurred between raising the interrupt for data each time had there been a restriction of having only one entry placed in the TX FIFO. †

This mode only occurs when I²C controller is acting as a slave-transmitter. If the remote master acknowledges the data sent by the slave-transmitter and there is no data in the slave's TX FIFO, the I²C controller raises the read request interrupt (RD_REQ) and waits for data to be written into the TX FIFO before it can be sent to the remote master. †

If the RD_REQ interrupt is masked, due to bit 5 (M_RD_REQ) of the IC_INTR_STAT register being set to 0, then it is recommended that the CPU does periodic reads of the IC_RAW_INTR_STAT register. Reads of IC_RAW_INTR_STAT that return bit 5 (R_RD_REQ) set to 1 must be treated as the equivalent of the RD_REQ interrupt referred to in this section.†

The RD_REQ interrupt is raised upon a read request, and like interrupts, must be cleared when exiting the interrupt service handling routine (ISR). The ISR allows you to either write 1 byte or more than 1 byte into the TX FIFO. During the transmission of these bytes to the master, if the master acknowledges the last byte then the slave must raise the RD_REQ again because the master is requesting for more data. †

If the programmer knows in advance that the remote master is requesting a packet of *n* bytes, then when another master addresses the I²C controller and requests data, the TX FIFO could be written with *n* number bytes and the remote master receives it as a continuous stream of data. For example, the I²C controller slave continues to send data to the remote master as long as the remote master is acknowledging the data sent and there is data available in the TX FIFO. There is no need to issue RD_REQ again. †

If the remote master is to receive *n* bytes from the I²C controller but the programmer wrote a number of bytes larger than *n* to the TX FIFO, then when the slave finishes sending the requested *n* bytes, it clears the TX FIFO and ignores any excess bytes. †

The I²C controller generates a transmit abort (TX_ABORT) event to indicate the clearing of the TX FIFO in this example. At the time an ACK/NACK is expected, if a NACK is received, then the remote master has all the data it wants. At this time, a flag is raised within the slave's state machine to clear the leftover data in the TX FIFO. This flag is transferred to the processor bus clock domain where the FIFO exists and the contents of the TX FIFO are cleared at that time. †

Master Mode Operation

This section discusses master mode procedures. †

Initial Configuration

For master mode operation, the target address and address format can be changed dynamically without having to disable the I²C controller. This feature is only applicable when the I²C controller is acting as a master because the slave requires the component to be disabled before any changes can be made to the address. To use the I²C controller as a master, perform the following steps: †

1. Disable the I²C controller by writing 0 to the IC_ENABLE register. †
2. Write to the IC_CON register to set the maximum speed mode supported for slave operation (bits 2:1) and to specify whether the I²C controller starts its transfers in 7/10 bit addressing mode when the device is a slave (bit 3). †
3. Write to the IC_TAR register the address of the I²C device to be addressed. It also indicates whether a General Call or a START BYTE command is going to be performed by I²C. The desired speed of the I²C controller master-initiated transfers, either 7-bit or 10-bit addressing, is controlled by the IC_10BITADDR_MASTER bit field (bit 12). †
4. Enable the I²C controller by writing a 1 in the IC_ENABLE register. †

- Now write the transfer direction and data to be sent to the IC_DATA_CMD register. If the IC_DATA_CMD register is written before the I²C controller is enabled, the data and commands are lost as the buffers are kept cleared when the I²C controller is not enabled. †



For multiple I²C transfers, perform additional writes to the TX FIFO such that the TX FIFO does not become empty during the I²C transaction. If the TX FIFO is completely emptied at any stage, then further writes to the TX FIFO results in an independent I²C transaction. †

Dynamic IC_TAR or IC_10BITADDR_MASTER Update

The I²C controller supports dynamic updating of the IC_TAR (bits 9:0) and IC_10BITADDR_MASTER (bit 12) bit fields of the IC_TAR register. You can dynamically write to the IC_TAR register provided the following conditions are met: †

- The I²C controller is not enabled (IC_ENABLE=0); †
- The I²C controller is enabled (IC_ENABLE=1); AND I²C controller is NOT engaged in any Master (TX, RX) operation (IC_STATUS[5]=0); AND I²C controller is enabled to operate in Master mode (IC_CON[0]=1); AND there are no entries in the TX FIFO (IC_STATUS[2]=1) †

Master Transmit and Master Receive

The I²C controller supports switching back and forth between reading and writing dynamically. To transmit data, write the data to be written to the lower byte of the I²C Rx/Tx Data Buffer and Command Register (IC_DATA_CMD). The CMD bit [8] should be written to 0 for I²C write operations. Subsequently, a read command may be issued by writing "don't cares" to the lower byte of the IC_DATA_CMD register, and a 1 should be written to the CMD bit. The I²C controller in master mode continues to initiate transfers as long as there are commands present in the transmit FIFO. If the transmit FIFO becomes empty, the I²C controller inserts a STOP condition after completing the current transfers. †

Disabling the I²C Controller

The register IC_ENABLE_STATUS is added to allow software to unambiguously determine when the hardware has completely shutdown in response to the IC_ENABLE register being set from 1 to 0. †

- Define a timer interval (ti2c_poll) equal to the 10 times the signaling period for the highest I²C transfer speed used in the system and supported by the I²C controller. For example, if the highest I²C transfer mode is 400 Kbps, then ti2c_poll is 25 us. †
- Define a maximum time-out parameter, MAX_T_POLL_COUNT, such that if any repeated polling operation exceeds this maximum value, an error is reported. †
- Execute a blocking thread/process/function that prevents any further I²C master transactions to be started by software, but allows any pending transfers to be completed.



This step can be ignored if the I²C controller is programmed to operate as an I²C slave only. †

4. The variable `POLL_COUNT` is initialized to zero. †
5. Set `IC_ENABLE` to 0. †
6. Read the `IC_ENABLE_STATUS` register and test the `IC_EN` bit (bit 0). Increment `POLL_COUNT` by one. If `POLL_COUNT` \geq `MAX_T_POLL_COUNT`, exit with the relevant error code. †
7. If `IC_ENABLE_STATUS[0]` is 1, then sleep for `ti2c_poll` and proceed to the previous step. Otherwise, exit with a relevant success code. †

DMA Controller Operation

To enable the DMA controller interface on the I²C controller, you must write the DMA Control Register (`IC_DMA_CR`). Writing a 1 to the `TDMAE` bit field of `IC_DMA_CR` register enables the I²C controller transmit handshaking interface. Writing a 1 to the `RDMAE` bit field of the `IC_DMA_CR` register enables the I²C controller receive handshaking interface. †



For details about the DMA controller, refer to the *DMA Controller* chapter in volume 3 of the *Cyclone V Device Handbook*.

The FIFO buffer depth (`FIFO_DEPTH`) for both the RX and TX buffers in the I²C controller is 64 entries.

Transmit FIFO Underflow

During I²C serial transfers, transmit FIFO requests are made to the DMA controller whenever the number of entries in the transmit FIFO is less than or equal to the value in DMA Transmit Data Level Register (`IC_DMA_TDLR`), also known as the watermark level. The DMA controller responds by writing a burst of data to the transmit FIFO buffer, of length specified as DMA burst length. †



For details about the DMA burst length microcode setup, refer to the *DMA Controller* chapter in volume 3 of the *Cyclone V Device Handbook*.

Data should be fetched from the DMA often enough for the transmit FIFO to perform serial transfers continuously, that is, when the FIFO begins to empty, another DMA request should be triggered. Otherwise, the FIFO will run out of data (underflow) causing a STOP to be inserted on the I²C bus. To prevent this condition, you must set the watermark level correctly. †

Transmit Watermark Level

Consider the example where the assumption is made: †

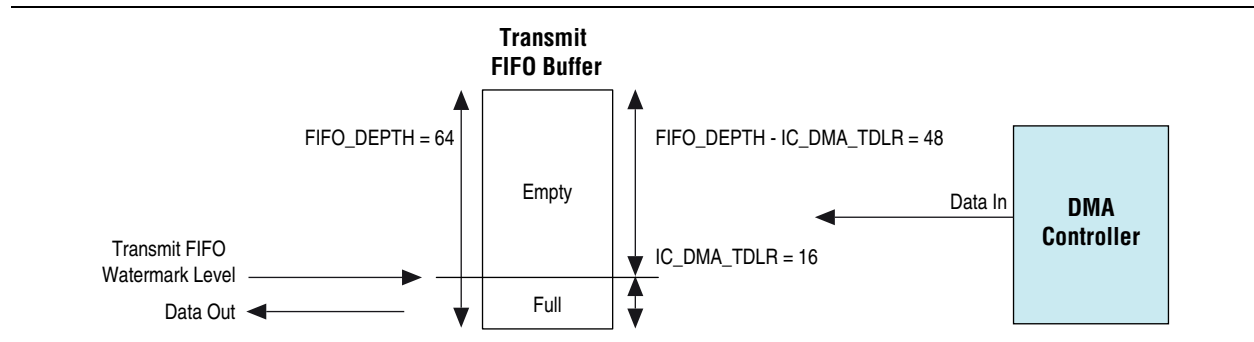
$$\text{DMA burst length} = \text{FIFO_DEPTH} - \text{IC_DMA_TDLR} \quad \dagger$$

Here the number of data items to be transferred in a DMA burst is equal to the empty space in the transmit FIFO. Consider the following two different watermark level settings: †

- Case 1: IC_DMA_TDLR = 16: †
 - Transmit FIFO watermark level = IC_DMA_TDLR = 16: †
 - DMA burst length = FIFO_DEPTH - IC_DMA_TDLR = 48: †
 - I²C transmit FIFO_DEPTH = 64: †
 - Block transaction size = 240: †

Figure 20-11 shows the transmit FIFO when the watermark level equals 16.

Figure 20-11. Transmit FIFO Watermark Level = 16



The number of burst transactions needed equals the block size divided by the number of data items per burst:

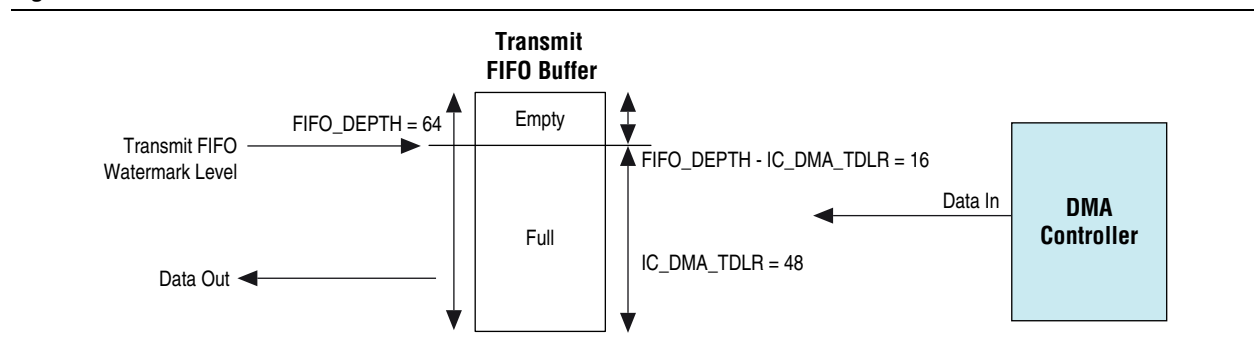
$$\text{Block transaction size} / \text{DMA burst length} = 240 / 48 = 5$$

The number of burst transactions in the DMA block transfer is 5. But the watermark level, IC_DMA_TDLR, is quite low. Therefore, the probability of transmit underflow is high where the I²C serial transmit line needs to transmit data, but there is no data left in the transmit FIFO. This occurs because the DMA has not had time to service the DMA request before the FIFO becomes empty.

- Case 2: IC_DMA_TDLR = 48 †
 - Transmit FIFO watermark level = IC_DMA_TDLR = 48 †
 - DMA burst length = FIFO_DEPTH - IC_DMA_TDLR = 16 †
 - I²C transmit FIFO_DEPTH = 64 †
 - Block transaction size = 240 †

Figure 20-12 shows the transmit FIFO when the watermark level equals 48.

Figure 20-12. Transmit FIFO Watermark Level = 48



Number of burst transactions in block: †

Block transaction size/DMA burst length = $240/16 = 15$ †

In this block transfer, there are 15 destination burst transactions in a DMA block transfer. But the watermark level, `IC_DMA_TDLR`, is high. Therefore, the probability of I²C transmit underflow is low because the DMA controller has plenty of time to service the destination burst transaction request before the I²C transmit FIFO becomes empty. †

Thus, the second case has a lower probability of underflow at the expense of more burst transactions per block. This provides a potentially greater amount of bursts per block and worse bus utilization than the former case. †

Therefore, the goal in choosing a watermark level is to minimize the number of transactions per block, while at the same time keeping the probability of an underflow condition to an acceptable level. In practice, this is a function of the ratio of the rate at which the I²C transmits data to the rate at which the DMA can respond to destination burst requests. †

Transmit FIFO Overflow

Setting the DMA burst length to a value greater than the watermark level that triggers the DMA request might cause overflow when there is not enough space in the transmit FIFO to service the destination burst request. Therefore, the following equation must be adhered to in order to avoid overflow: †

DMA burst length \leq `FIFO_DEPTH - IC_DMA_TDLR`

In case 2: `IC_DMA_TDLR = 48`, the amount of space in the transmit FIFO at the time of the burst request is made is equal to the DMA burst length. Thus, the transmit FIFO may be full, but not overflowed, at the completion of the burst transaction. †

Therefore, for optimal operation, DMA burst length should be set at the FIFO level that triggers a transmit DMA request; that is: †

DMA burst length = `FIFO_DEPTH - IC_DMA_TDLR`

Adhering to this equation reduces the number of DMA bursts needed for block transfer, and this in turn improves bus utilization. †



The transmit FIFO will not be full at the end of a DMA burst transfer if the I²C controller has successfully transmitted one data item or more on the I²C serial transmit line during the transfer. †

Receive FIFO Overflow

During I²C serial transfers, receive FIFO requests are made to the DMA whenever the number of entries in the receive FIFO is at or above the DMA Receive Data Level Register, that is `IC_DMA_RDLR + 1`. This is known as the watermark level. The DMA responds by fetching a burst of data from the receive FIFO. †

Data should be fetched by the DMA often enough for the receive FIFO to accept serial transfers continuously, that is, when the FIFO begins to fill, another DMA transfer is requested. Otherwise the FIFO will fill with data (overflow). To prevent this condition, the user must set the watermark level correctly. †

Receive Watermark Level

Similar to choosing the transmit watermark level described earlier, the receive watermark level, `IC_DMA_RDLR + 1`, should be set to minimize the probability of overflow, as shown in Figure 20-13. It is a trade off between the number of DMA burst transactions required per block versus the probability of an overflow occurring. †

Receive FIFO Underflow

Setting the source transaction burst length greater than the watermark level can cause underflow where there is not enough data to service the source burst request. Therefore, the following equation must be adhered to avoid underflow: †

$$\text{DMA burst length} = \text{IC_DMA_RDLR} + 1$$

If the number of data items in the receive FIFO is equal to the source burst length at the time of the burst request is made, the receive FIFO may be emptied, but not underflowed, at the completion of the burst transaction. For optimal operation, DMA burst length should be set at the watermark level, `IC_DMA_RDLR + 1`. †

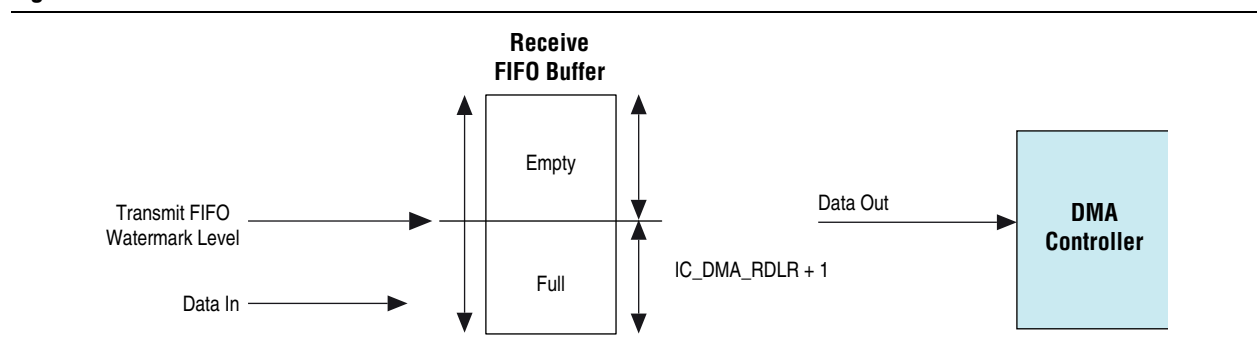
Adhering to this equation reduces the number of DMA bursts in a block transfer, which in turn can avoid underflow and improve bus utilization. †



The receive FIFO will not be empty at the end of the source burst transaction if the I²C controller has successfully received one data item or more on the I²C serial receive line during the burst. †

Figure 20-13 shows the receive FIFO buffer.

Figure 20-13. Receive FIFO Buffer



I²C Controller Address Map and Register Definitions



The address map and register definitions reside in the [hps.html](#) file that accompanies this handbook volume. Click the link to open the file.

To view the module description and base address, scroll to and click the link for any of the following module instances:

- `i2c0`
- `i2c1`

■ i2c2

■ i2c3

To then view the register and field descriptions, scroll to and click the register names. The register addresses are offsets relative to the base address of each module instance.



The base addresses of all modules are also listed in the *Introduction to the Hard Processor System* chapter in volume 3 of the *Cyclone V Device Handbook*.

Document Revision History

Table 20-3 shows the revision history for this document.

Table 20-3. Document Revision History

Date	Version	Changes
November 2012	1.2	Minor updates.
May 2012	1.1	Added programming model, address map and register definitions, clocks, reset, and interface pins sections.
January 2012	1.0	Initial release.

The hard processor system (HPS) provides two UART controllers for asynchronous serial communication. The UART controllers are based on an industry standard 16550 UART controller. The UART controllers are instances of the Synopsys® DesignWare® APB Universal Asynchronous Receiver/Transmitter (DW_apb_uart) peripheral.

UART Controller Features

The UART controller provides the following functionality and features:

- Programmable character properties, such as number of data bits per character, optional parity bits, and number of stop bits †
- Line break generation and detection †
- Direct memory access (DMA) controller interface
- Prioritized interrupt identification †
- Programmable baud rate
- False start bit detection †
- Automatic flow control mode per 16750 standard †
- Internal loopback mode support
- 128-bit transmit and receive FIFO buffer depth
 - FIFO buffer status registers †
 - FIFO buffer access mode (for FIFO buffer testing) enables write of receive FIFO buffer by master and read of transmit FIFO buffer by master †
- Shadow registers reduce software overhead and provide programmable reset †
- Transmitter holding register empty (THRE) interrupt mode †

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UART Controller Block Diagram and System Integration

Figure 21-1 shows the integration of the UART controller in the HPS system.

Figure 21-1. UART Block Diagram

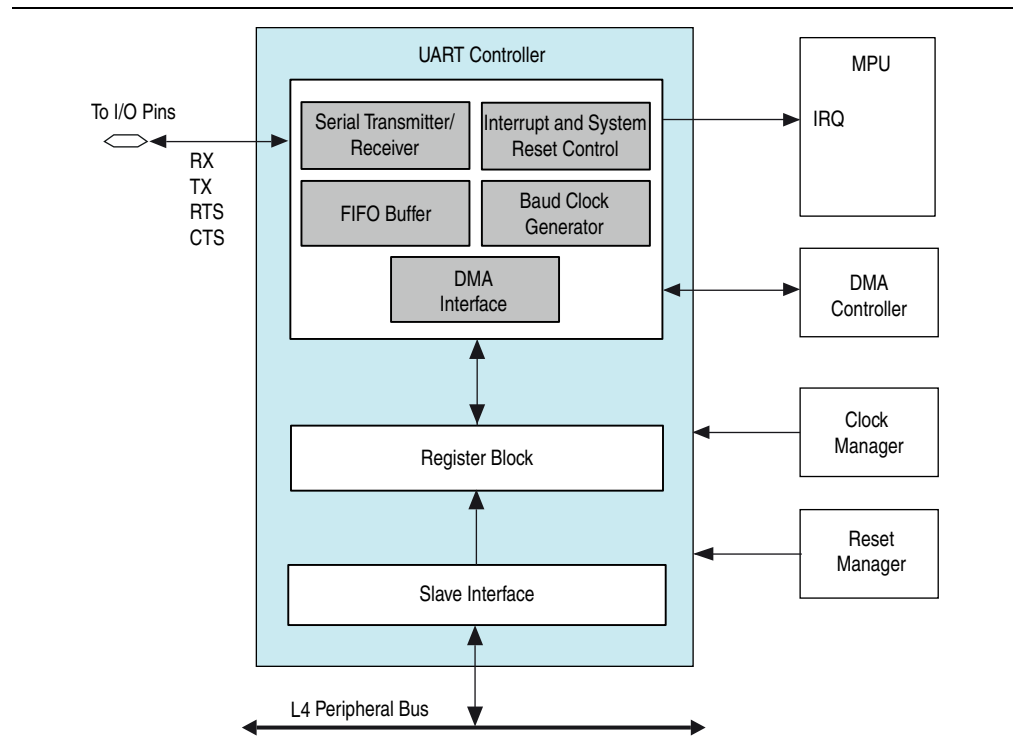


Table 21-1 provides a summary description of the major blocks in the UART controller.

Table 21-1. UART Controller Block Descriptions

Block	Description
Slave interface	Slave interface between the component and L4 peripheral bus.
Register block	Provides main UART control, status, and interrupt generation functions. †
FIFO buffer	Provides FIFO buffer control and storage. †
Baud clock generator	Generates the transmitter and receiver baud clock. With a reference clock of 100 MHz, the UART controller supports transfer rates of 95 baud to 6.25 Mbaud. This supports communication with all known 16550 devices. The baud rate is controlled by programming the interrupt enable or divisor latch high (IER_DLH) and receive buffer, transmit holding, or divisor latch low (RBR_THR_DLL) registers.
Serial transmitter	Converts parallel data written to the UART into serial data and adds all additional bits, as specified by the control register, for transmission. This makeup of serial data, referred to as a character, exits the block in serial UART. †

Table 21–1. UART Controller Block Descriptions

Block	Description
Serial receiver	Converts the serial data character (as specified by the control register) received in the UART format to parallel form. Parity error detection, framing error detection and line break detection is carried out in this block. †
DMA interface	<p>The UART controller includes a DMA controller interface to indicate when received data is available or when the transmit FIFO buffer requires data. The DMA requires two channels, one for transmit and one for receive. The UART controller supports single and burst transfers. You can use DMA in FIFO buffer and non-FIFO buffer mode.</p> <p>For more specific information, refer to the <i>DMA Controller</i> chapter in volume 3 of the <i>Cyclone® V Device Handbook</i>.</p>

Functional Description of the UART Controller

The HPS UART is based on an industry-standard 16550 UART. The UART supports serial communication with a peripheral, modem (data carrier equipment), or data set. The master (CPU) writes data over the slave bus to the UART. The UART converts the data to serial format and transmits to the destination device. The UART also receives serial data and stores it for the master (CPU). †

The UART's registers control the character length, baud rate, parity generation and checking, and interrupt generation. The UART's single interrupt output signal is supported by several prioritized interrupt types that trigger assertion. You can separately enable or disable each of the interrupt types with the control registers. †

FIFO Buffer Support

The UART controller includes 128-byte FIFO buffers to buffer transmit and receive data. FIFO buffer access mode allows the master to write the receive FIFO buffer and to read the transmit FIFO buffer for test purposes. FIFO buffer access mode is enabled with the FIFO access register (FAR). Once enabled, the control portions of the transmit and receive FIFO buffers are reset and the FIFO buffers are treated as empty. †

When FIFO buffer access mode is enabled, you can write data to the transmit FIFO buffer as normal; however, no serial transmission occurs in this mode and no data leaves the FIFO buffer. You can read back the data that is written to the transmit FIFO buffer with the transmit FIFO read (TFR) register. The TFR register provides the current data at the top of the transmit FIFO buffer. †

Similarly, you can also read data from the receive FIFO buffer in FIFO buffer access mode. Since the normal operation of the UART is halted in this mode, you must write data to the receive FIFO buffer to read it back. The receive FIFO write (RFW) register writes data to the receive FIFO buffer. The upper two bits of the 10-bit register write framing errors and parity error detection information to the receive FIFO buffer. Bit 9 of RFW indicates a framing error and bit 8 of RFW indicates a parity error. Although you cannot read these bits back from the receive buffer register, you can check the bits by reading the line status register (LSR), and by checking the corresponding bits when the data in question is at the top of the receive FIFO buffer. †

Automatic Flow Control

The UART includes 16750-compatible request-to-send (RTS) and clear-to-send (CTS) serial data automatic flow control mode. You enable automatic flow control with the modem control register (`MCR.AFCE`). †

Automatic RTS mode

Automatic RTS mode becomes active when the following conditions occur: †

- RTS (`MCR.RTS` bit and `MCR.AFCE` bit are both set)
- FIFO buffers are enabled (`IIR_FCR.FIFOE` bit is set)

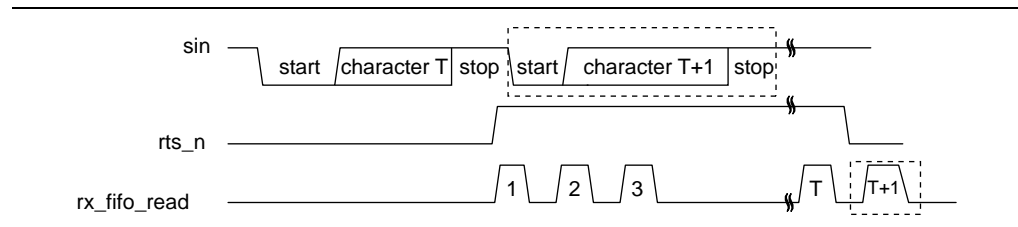
When automatic RTS is enabled, the `rts_n` output pin is forced inactive (high) when the receive FIFO buffer level reaches the threshold set by RCVR trigger (`IIR_FCR.RT`). When `rts_n` is connected to the `cts_n` input pin of another UART device, the other UART stops sending serial data until the receive FIFO buffer has available space (until it is completely empty). †

The selectable receive FIFO buffer threshold values are 1, $\frac{1}{4}$, $\frac{1}{2}$, and 2 less than full. Because one additional character may be transmitted to the UART after `rts_n` is inactive (due to data already having entered the transmitter block in the other UART), setting the threshold to 2 less than full allows maximum use of the FIFO buffer with a margin of one character. †

Once the receive FIFO buffer is completely emptied by reading the receiver buffer register (`RBR_THR_DLL`), `rts_n` again becomes active (low), signalling the other UART to continue sending data. †

Even when you set the correct `MCR` bits, if the FIFO buffers are disabled through `FCR.FIFOE`, automatic flow control is also disabled. When auto RTS is not implemented or disabled, `rts_n` is controlled solely by `MCR.RTS`. Figure 21-2 illustrates automatic RTS operation. In Figure 21-2, the character T is received because `rts_n` is not detected prior to the next character entering the sending UART transmitter. †

Figure 21-2. Automatic RTS Timing



Automatic CTS mode

Automatic CTS mode becomes active when the following conditions occur: †

- AFCE (`MCR.AFCE` bit is set)
- FIFO buffers are enabled (through FIFO buffer control register `IIR_FCR.FIFOE`) bit

When automatic CTS is enabled (active), the UART transmitter is disabled whenever the `cts_n` input becomes inactive (high). This prevents overflowing the FIFO buffer of the receiving UART. †

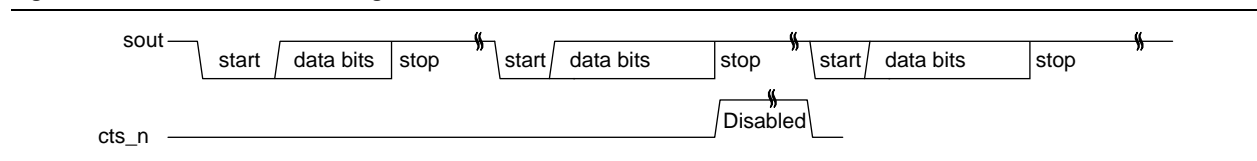
If the `cts_n` input is not deactivated before the middle of the last stop bit, another character is transmitted before the transmitter is disabled. While the transmitter is disabled, you can continue to write and even overflow to the transmit FIFO buffer. †

Automatic CTS mode requires the following sequence:

1. The UART status register are read to verify that the transmit FIFO buffer is full (UART status register `USR.TFNF` set to zero). †
2. The current FIFO buffer level is read via the transmit FIFO level (TFL) register. †
3. Programmable THRE interrupt mode must be enabled to access the FIFO buffer full status from the LSR. †

When using the FIFO buffer full status, software can poll this before each write to the transmit FIFO buffer. When the `cts_n` input becomes active (low) again, transmission resumes. If the FIFO buffers are disabled with the `IIR_FCR.FIFOE` bit, automatic flow control is also disabled regardless of any other settings. When auto CTS is not implemented or disabled, the transmitter is unaffected by `cts_n`. Figure 21-3 timing diagram shows auto CTS operation.†

Figure 21-3. Automatic CTS Timing



Clocks

The UART controller is connected to the `l4_sp_clk` clock. The clock input is driven by the clock manager.



For more information about the clock manager, refer to the [Clock Manager](#) chapter in volume 3 of the *Cyclone V Device Handbook*.

Resets

The UART controller is connected to the `uart_rst_n` reset signal. The reset manager drives the signal on a cold or warm reset.

For more information, refer to the [Reset Manager](#) chapter in volume 3 of the *Cyclone V Device Handbook*.

Interrupts

The assertion of the UART interrupt output signal occurs when one of the following interrupt types are enabled and active: †

Table 21-2. Interrupt Types and Priority †

Interrupt Type	Priority
Receiver line status	Highest
Received data available	Second

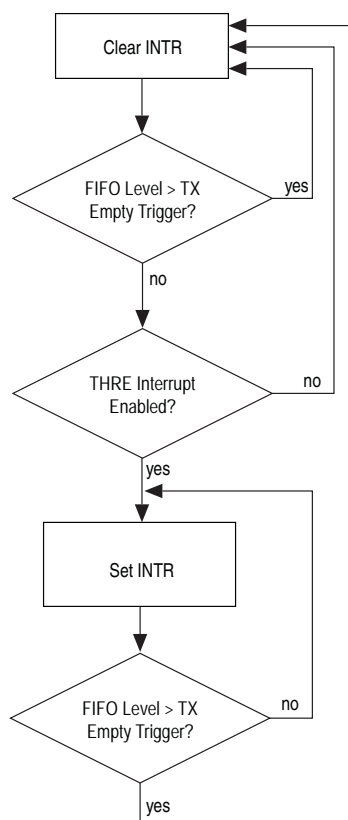
Table 21–2. Interrupt Types and Priority †

Interrupt Type	Priority
Character timeout indication	Second
Transmit holding register empty	Third

You can enable the interrupt types with the interrupt enable register (IER_DLH).

Programmable THRE Interrupt

The UART has a programmable THRE interrupt mode to increase system performance. You enable the programmable THRE interrupt mode with the interrupt enable register (IER_DLH.PTIME). When the THRE mode is enabled, THRE interrupts and the dma_tx_req signal are active at and below a programmed transmit FIFO buffer empty threshold level, as shown in the flowchart in [Figure 21–4](#). †

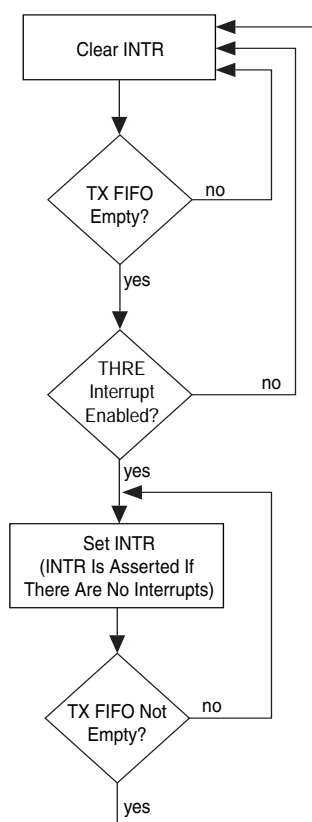
Figure 21–4. Programmable THRE Interrupt Mode

The threshold level is programmed into IIR_FCR.TET. The available empty thresholds are empty, 2, $\frac{1}{4}$, and $\frac{1}{2}$. The optimum threshold value depends on the system's ability to begin a new transmission sequence in a timely manner. However, one of these thresholds should prove optimum in increasing system performance by preventing the transmit FIFO buffer from running empty.

In addition to the interrupt change, line status register (LSR.THRE) also switches from indicating that the transmit FIFO buffer is empty, to indicating that the FIFO buffer is full. This change allows software to fill the FIFO buffer for each transmit sequence by polling LSR.THRE before writing another character. This directs the UART to fill the transmit FIFO buffer whenever an interrupt occurs and there is data to transmit, instead of waiting until the FIFO buffer is completely empty. Waiting until the FIFO buffer is empty reduces performance whenever the system is too busy to respond immediately. You can increase system efficiency when this mode is enabled in combination with automatic flow control.

When not selected or disabled, THRE interrupts and LSR.THRE function normally, reflecting an empty THR or FIFO buffer. Figure 21-5 illustrates THRE interrupt generation when not in programmable THRE interrupt mode.

Figure 21-5. Interrupt Generation without Programmable THRE Interrupt Mode



UART Controller Programming Model

This section describes the programming model for the UART controller.

DMA Controller Operation

The UART controller includes a DMA controller interface to indicate when the receive FIFO buffer data is available or when the transmit FIFO buffer requires data. The DMA requires two channels, one for transmit and one for receive. The UART controller supports both single and burst transfers.



For details about the DMA controller, refer to the *DMA Controller* chapter in volume 3 of the *Cyclone V Device Handbook*.

The FIFO buffer depth (FIFO_DEPTH) for both the RX and TX buffers in the UART controller is 128 entries.

Transmit FIFO Underflow

During UART serial transfers, transmit FIFO requests are made to the DMA controller whenever the number of entries in the transmit FIFO is less than or equal to the decoded level of the Transmit Empty Trigger (TET) field in the FIFO Control Register (IIR_FCR), also known as the watermark level. The DMA controller responds by writing a burst of data to the transmit FIFO buffer, of length specified as DMA burst length. †



For details about the DMA burst length microcode setup, refer to the *DMA Controller* chapter in volume 3 of the *Cyclone V Device Handbook*.

Data should be fetched from the DMA often enough for the transmit FIFO to perform serial transfers continuously, that is, when the FIFO begins to empty, another DMA request should be triggered. Otherwise, the FIFO will run out of data (underflow) causing a STOP to be inserted on the UART bus. To prevent this condition, you must set the watermark level correctly. †

Transmit Watermark Level

Consider the example where the following assumption is made: †

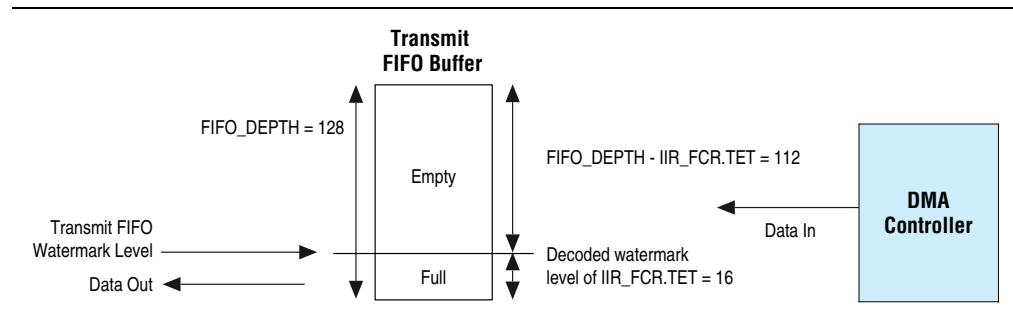
$$\text{DMA burst length} = \text{FIFO_DEPTH} - \text{decoded watermark level of IIR_FCR.TET} \dagger$$

Here the number of data items to be transferred in a DMA burst is equal to the empty space in the transmit FIFO. Consider the following two different watermark level settings: †

- Case 1: IIR_FCR.TET = 1, which decodes to a watermark level of 16: †
 - Transmit FIFO watermark level = decoded watermark level of IIR_FCR.TET = 16 †
 - DMA burst length = FIFO_DEPTH - decoded watermark level of IIR_FCR.TET = 112 †
 - UART transmit FIFO_DEPTH = 128 †
 - Block transaction size = 448†

Figure 21-6 shows the transmit FIFO when the watermark level equals 16.

Figure 21-6. Transmit FIFO Watermark Level = 16



The number of burst transactions needed equals the block size divided by the number of data items per burst:

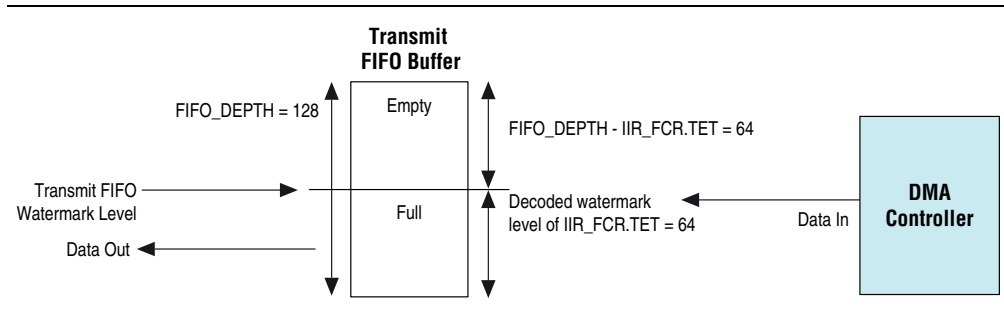
$$\text{Block transaction size/DMA burst length} = 448/112 = 4$$

The number of burst transactions in the DMA block transfer is 4. But the watermark level, decoded level of `IIR_FCR.TET`, is quite low. Therefore, the probability of transmit underflow is high where the UART serial transmit line needs to transmit data, but there is no data left in the transmit FIFO. This occurs because the DMA has not had time to service the DMA request before the FIFO becomes empty.

- Case 2: `IIR_FCR.TET = 3`, which decodes to a watermark level of 64: †
 - Transmit FIFO watermark level = decoded watermark level of `IIR_FCR.TET = 64` †
 - DMA burst length = `FIFO_DEPTH - decoded watermark level of IIR_FCR.TET = 64` †
 - UART transmit `FIFO_DEPTH = 128` †
 - Block transaction size = 448 †

Figure 21-7 shows the transmit FIFO when the watermark level equals 64.

Figure 21-7. Transmit FIFO Watermark Level = 64



Number of burst transactions in block: †

Block transaction size/DMA burst length = $448/64 = 7$ †

In this block transfer, there are 15 destination burst transactions in a DMA block transfer. But the watermark level, decoded level of `IIR_FCR.TET`, is high. Therefore, the probability of UART transmit underflow is low because the DMA controller has plenty of time to service the destination burst transaction request before the UART transmit FIFO becomes empty. †

Thus, the second case has a lower probability of underflow at the expense of more burst transactions per block. This provides a potentially greater amount of bursts per block and worse bus utilization than the former case. †

Therefore, the goal in choosing a watermark level is to minimize the number of transactions per block, while at the same time keeping the probability of an underflow condition to an acceptable level. In practice, this is a function of the ratio of the rate at which the UART transmits data to the rate at which the DMA can respond to destination burst requests. †

Transmit FIFO Overflow

Setting the DMA burst length to a value greater than the watermark level that triggers the DMA request might cause overflow when there is not enough space in the transmit FIFO to service the destination burst request. Therefore, the following equation must be adhered to in order to avoid overflow: †

DMA burst length \leq FIFO_DEPTH - decoded watermark level of `IIR_FCR.TET`

In case 2: decoded watermark level of `IIR_FCR.TET` = 64, the amount of space in the transmit FIFO at the time of the burst request is made is equal to the DMA burst length. Thus, the transmit FIFO may be full, but not overflowed, at the completion of the burst transaction. †

Therefore, for optimal operation, DMA burst length should be set at the FIFO level that triggers a transmit DMA request; that is: †

DMA burst length = FIFO_DEPTH - decoded watermark level of `IIR_FCR.TET`

Adhering to this equation reduces the number of DMA bursts needed for block transfer, and this in turn improves bus utilization. †



The transmit FIFO will not be full at the end of a DMA burst transfer if the UART controller has successfully transmitted one data item or more on the UART serial transmit line during the transfer. †

Receive FIFO Overflow

During UART serial transfers, receive FIFO requests are made to the DMA whenever the number of entries in the receive FIFO is at or above the decoded level of Receive Trigger (RT) field in the FIFO Control Register (IIR_FCR). This is known as the watermark level. The DMA responds by fetching a burst of data from the receive FIFO. †

Data should be fetched by the DMA often enough for the receive FIFO to accept serial transfers continuously, that is, when the FIFO begins to fill, another DMA transfer is requested. Otherwise the FIFO will fill with data (overflow). To prevent this condition, the user must set the watermark level correctly. †

Receive Watermark Level

Similar to choosing the transmit watermark level described earlier, the receive watermark level, decoded watermark level of IIR_FCR.RT, should be set to minimize the probability of overflow, as shown in Figure 21-8. It is a tradeoff between the number of DMA burst transactions required per block versus the probability of an overflow occurring. †

Receive FIFO Underflow

Setting the source transaction burst length greater than the watermark level can cause underflow where there is not enough data to service the source burst request. Therefore, the following equation must be adhered to avoid underflow: †

$$\text{DMA burst length} = \text{decoded watermark level of IIR_FCR.RT} + 1$$

If the number of data items in the receive FIFO is equal to the source burst length at the time of the burst request is made, the receive FIFO may be emptied, but not underflowed, at the completion of the burst transaction. For optimal operation, DMA burst length should be set at the watermark level, decoded watermark level of IIR_FCR.RT. †

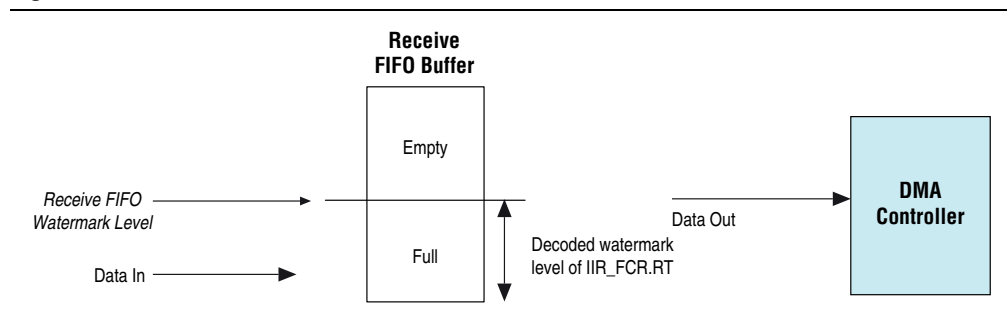
Adhering to this equation reduces the number of DMA bursts in a block transfer, which in turn can avoid underflow and improve bus utilization. †



The receive FIFO will not be empty at the end of the source burst transaction if the UART controller has successfully received one data item or more on the UART serial receive line during the burst. †

Figure 21-8 shows the receive FIFO buffer.

Figure 21-8. Receive FIFO Buffer



UART Controller Address Map and Register Definitions

The address map and register definitions reside in the [hps.html](#) file that accompanies this handbook volume. Click the link to open the file.

To view the module description and base address, scroll to and click the link for either of the following module instances:

- **uart0**
- **uart1**

To then view the register and field descriptions, scroll to and click the register names. The register addresses are offsets relative to the base address of each module instance.

The base addresses of all modules are also listed in the *Introduction to the Hard Processor System* chapter in volume 3 of the *Cyclone V Device Handbook*.

Document Revision History

Table 21-3 shows the revision history for this document.

Table 21-3. Document Revision History

Date	Version	Changes
November 2012	1.2	Minor updates.
May 2012	1.1	Added programming model, address map and register definitions, and reset sections.
January 2012	1.0	Initial release.

The hard processor system (HPS) provides three general-purpose I/O (GPIO) interface modules. The GPIO modules are instances of the Synopsys® DesignWare® APB General Purpose Programming I/O (DW_apb_gpio) peripheral.

Features of the GPIO Interface

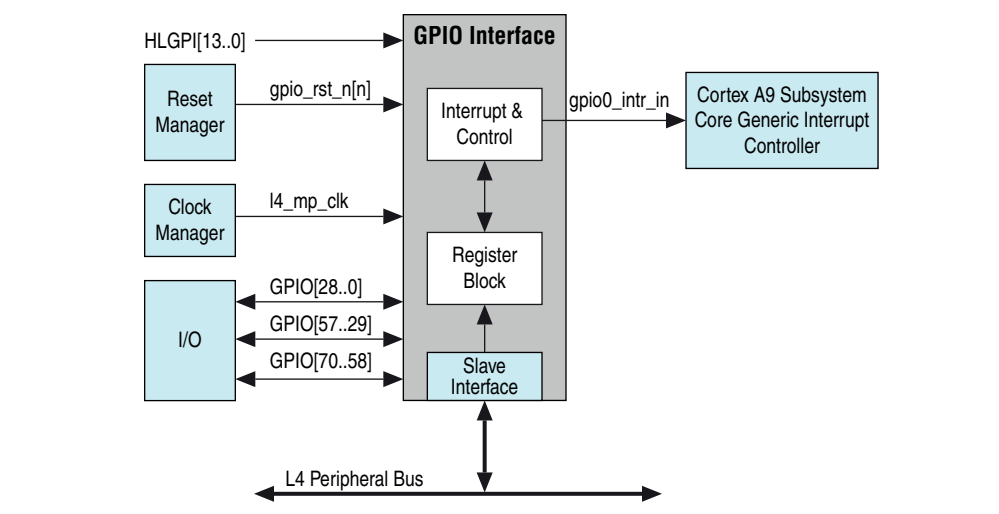
The GPIO interface offers the following features:

- Supports digital de-bounce
- Configurable interrupt mode
- Supports up to 71 I/O pins and 14 input-only pins

GPIO Interface Block Diagram and System Integration

Figure 22–1 shows a block diagram of the GPIO interface.

Figure 22–1. GPIO Interface Block Diagram



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†Paragraphs marked with the dagger (†) symbol are Synopsys Proprietary. Used with permission.



Functional Description of the GPIO Interface

This section provides functional details of the GPIO interface.

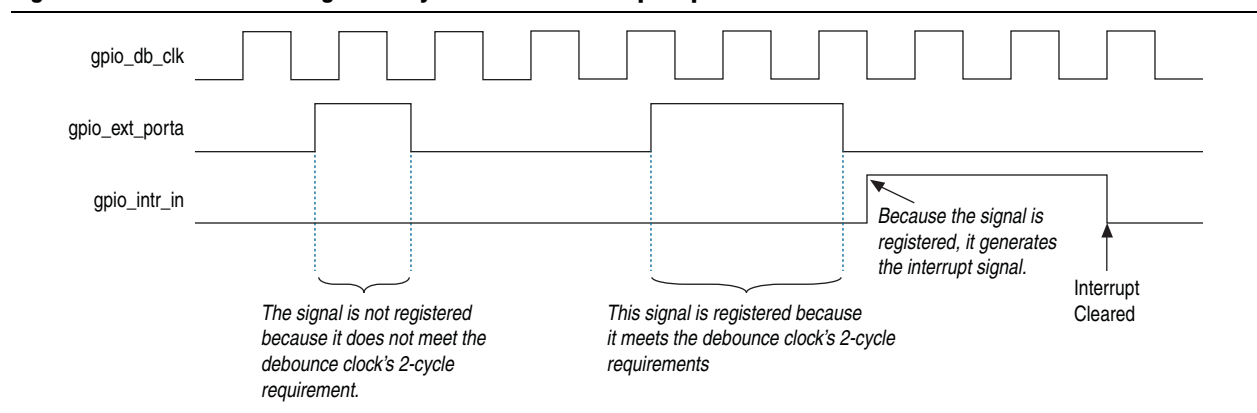
Debounce Operation

The GPIO modules provided in the HPS include optional debounce capabilities. The external signal can be debounced to remove any spurious glitches that are less than one period of the external debouncing clock, `gpio_db_clk`.

When input interrupt signals are debounced using the `gpio_db_clk` debounce clock, the signals must be active for a minimum of two cycles of the debounce clock to guarantee that they are registered. Any input pulse widths less than a debounce clock period are filtered out. If the input signal pulse width is between one and two debounce clock widths it may or may not be filtered out, depending on its phase relationship to the debounce clock. If the input pulse spans two rising edges of the debounce clock, it is registered. If it spans only one rising edge, it is not registered.

Figure 22-2 shows a timing diagram of the debounce circuitry for both cases: a bounced input signal, and later, a propagated input signal..

Figure 22-2. Debounce Timing With Asynchronous Reset Flip-Flops



Enabling the debounce circuitry increases interrupt latency by two clock cycles of the debounce clock.

Pin Directions


The pins GPIO0 through GPIO70 can be configured to be either input or output signals. The pins HLGPI0 through HLGPI13 share pins with the HPS DDR controller and are input-only signals.

GPIO Interface Programming Model

Debounce capability for each of the input signals on port A can be enabled or disabled under software control by setting the corresponding bits in the `gpio_debounce` register accordingly. The debounce clock must be stable and operational before the debounce capability is enabled.

Under software control, the direction of the external I/O pad is controlled by a write to the `gpio_swportx_ddr` register. When configured as input mode, reading `gpio_ext_porta` would read the values on the signal of the external I/O pad. When configured as output mode, the data written to the `gpio_swporta_dr` register drives the output buffer of the I/O pad. The same pins are shared for both input and output modes, so they cannot be configured as input and output modes at the same time.


GPIO Interface Address Map and Register Definitions

 The address map and register definitions reside in the [hps.html](#) file that accompanies this handbook volume. Click the link to open the file.

To view the module description and base address, scroll to and click the link for any of the following module instances:

- `gpio0`
- `gpio1`
- `gpio2`

To then view the register and field descriptions, scroll to and click the register names. The register addresses are offsets relative to the base address of each module instance.

 The base addresses of all modules are also listed in the *Introduction to the Hard Processor System* chapter in volume 3 of the *Cyclone V Device Handbook*.

Document Revision History

Table 22-1 shows the revision history for this document.

Table 22-1. Document Revision History

Date	Version	Changes
November 2012	1.2	Minor updates.
May 2012	1.1	Added programming model section.
January 2012	1.0	Initial release.

The hard processor system (HPS) provides four, 32-bit, general-purpose timers connected to the level 4 (L4) peripheral bus. The timers optionally generate an interrupt when the 32-bit binary count-down timer reaches zero. The timers are instances of the Synopsys® DesignWare® APB Timers (DW_apb_timers) peripheral.



The microprocessor unit (MPU) subsystem provides additional timers. For information about the timers in the MPU, refer to the *Cortex-A9 MPU System* chapter in volume 3 of the *Cyclone V Device Handbook*.

Features of the Timer

- Supports interrupt generation
- Supports free-running mode
- Supports user-defined count mode

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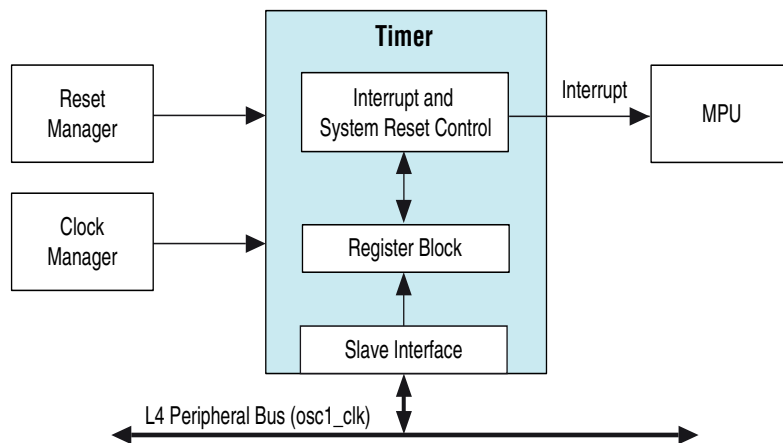
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Timer Block Diagram and System Integration

Figure 23-1 shows a block diagram of the timer. Each timer includes a slave interface for control and status register (CSR) access, a register block, and a programmable 32-bit down counter that generates interrupts on reaching zero. The timer operates on a single clock domain driven by the clock manager.

Figure 23-1. Timer Block Diagram



Functional Description of the Timer

The 32-bit timer counts down from a programmed value and generates an interrupt when the count reaches zero. The timer has an independent clock input connected to the system clock signal or to an external clock source. †

The timer supports the following modes of operation:

- Free-running mode—decrementing from the maximum value (0xFFFFFFFF). Reloads maximum value upon reaching zero.
- User-defined count mode—generates a periodic interrupt. Decrements from the user-defined count value loaded from the timer1 load count register (timer1loadcount). Reloads the user-defined count upon reaching zero.

The initial value for the timer (that is, the value from which it counts down) is loaded into the timer by the timer1loadcount register. The following events can cause a timer to load the initial count from the timer1loadcount register: †

- Timer is enabled after being reset or disabled
- Timer counts down to 0

Clocks

Table 23–1 shows the clock signals and connections associated with the timers.

Table 23–1. Timer Clock Characteristics

Timer	System Clock	Notes
OSC1 timer 0	osc1_clk	—
OSC1 timer 1		
SP timer 0	l4_sp_clk	Timer must be disabled if clock frequency changes
SP timer 1		

SP timer 0 and SP timer 1 must be disabled before l4_sp_clk is changed to another frequency. You can then re-enable the timer once the clock frequency change takes effect. You cannot change the frequency of OSC1 timer 0 and OSC1 timer 1.



For more information about clock performance, refer to the *Clock Manager* chapter in volume 3 of the *Cyclone V Device Handbook*.

Resets

The timers are reset by a cold or warm reset. Resetting the timers produces the following results:

1. The timer is disabled
2. The interrupt is enabled
3. The timer enters free-running mode
4. The timer count load register value is set to zero

Interrupts

The timer1 interrupt status (timer1intstat) and timer1 end of interrupt (timer1eoi) registers handle the interrupts. The timer1intstat register allows you to read the status of the interrupt. Reading from the timer1eoi register returns the value 0 and clears the interrupt. †

The timer1 control register (timer1controlreg) contains the timer1 interrupt mask bit (timer1_interrupt_mask) to mask the interrupt. In both the free-running and user-defined count modes of operation, the timer generates an interrupt signal when the timer count reaches zero and the interrupt mask bit of the control register is high.

If the timer interrupt is set, then it is cleared when the timer is disabled.

Timer Programming Model

This section describes the programming model for the timer.

Initialization

To initialize the timer, perform the following steps: †

1. Initialize the timer through the `timer1controlreg` register: †
 - a. Disable the timer by writing a 0 to the `timer1_enable` bit (`timer1_enable`) of the `timer1controlreg` register. †

Before writing to a timer1 load count register (`timer1loadcount`), you must disable the timer by writing a 0 to the `timer1_enable` bit of the `timer1controlreg` register to avoid potential synchronization problems. †
 - b. Program the timer mode—user-defined count or free-running—by writing a 0 or 1, respectively, to the `timer1_mode` bit (`timer1_mode`) of the `timer1controlreg` register. †
 - c. Set the interrupt mask as either masked or not masked by writing a 1 or 0, respectively, to the `timer1_interrupt_mask` bit of the `timer1controlreg` register. †
2. Load the timer counter value into the `timer1loadcount` register. †
3. Enable the timer by writing a 1 to the `timer1_enable` bit of the `timer1controlreg` register. †

Enabling or Disabling the Timer

To enable the timer, write a 1 to the `timer1_enable` bit of the `timer1controlreg` register. To disable the timer, write a 0 to the `timer1_enable` bit. †

When a timer transitions to the enabled state, the current value of `timer1loadcount` register is loaded into the timer counter. †

When the timer enable bit is cleared to 0, the timer counter and any associated registers in the timer clock domain, are asynchronously reset. †

Loading the Timer Countdown Value

When a timer counter is enabled after being reset or disabled, the count value is loaded from the `timer1loadcount` register; this occurs in both free-running and user-defined count modes. †

When a timer counts down to 0, it loads one of two values, depending on the timer operating mode: †

- User-defined count mode—timer loads the current value of the `timer1loadcount` register. Use this mode if you want a fixed, timed interrupt. Designate this mode by writing a 1 to the `timer1_mode` bit of the `timer1controlreg` register. †

- Free-running mode—timer loads the maximum value (0xFFFFFFFF). The timer max count value allows for a maximum amount of time to reprogram or disable the timer before another interrupt occurs. Use this mode if you want a single timed interrupt. Enable this mode by writing a 0 to the `timer1_mode` bit of the `timer1controlreg` register. †

Servicing Interrupts

This section discusses various interrupt cases and how to service them.

Clearing Interrupt

You can clear an active timer interrupt by reading the `timerleoi` register or by disabling the timer. When the timer is enabled, its interrupt remains asserted until it is cleared by reading the `timerleoi` register. †

If you clear the interrupt at the same time as the timer reaches 0, the interrupt remains asserted. This is because setting the timer interrupt takes precedence over clearing the interrupt. †


Checking Interrupt Status

You can query the interrupt status of the timer without clearing its interrupt. To check the interrupt status, read the `timerlintstat` register. †

Masking Interrupt

The timer interrupt can be masked using the `timer1controlreg` register. To mask an interrupt, write a 1 to the `timer1_interrupt_mask` bit of the `timer1controlreg` register. †


Timer Address Map and Register Definitions

-  The address map and register definitions reside in the [hps.html](#) file that accompanies this handbook volume. Click the link to open the file.

To view the module description and base address, scroll to and click the link for any of the following module instances:

- `osc1timer0`
- `osc1timer1`
- `sptimer0`
- `sptimer1`

To then view the register and field descriptions, scroll to and click the register names. The register addresses are offsets relative to the base address of each module instance.

-  The base addresses of all modules are also listed in the [Introduction to the Hard Processor System](#) chapter in volume 3 of the *Cyclone V Device Handbook*.

Document Revision History

Table 23-2 shows the revision history for this document.

Table 23-2. Document Revision History

Date	Version	Changes
November 2012	1.2	Minor updates.
May 2012	1.1	Added programming model and address map and register definitions sections.
January 2012	1.0	Initial release.

The primary function of a watchdog timer is to provide a way for the system to recover from an unresponsive state. The hard processor system (HPS) provides two programmable watchdog timers, which are connected to the level 4 (L4) peripheral bus. The watchdog timers are instances of the Synopsys® DesignWare® APB Watchdog Timer (DW_apb_wdt) peripheral.



The microprocessor unit (MPU) subsystem provides two additional watchdog timers. For information about the watchdog timers in the MPU, refer to the *Cortex-A9 MPU System* chapter in volume 3 of the *Cyclone V Device Handbook*.

Features of the Watchdog Timer

The following list describes the features of the watchdog timer:

- Programmable 32-bit timeout range
- Timer counts down from a preset value to zero, then performs one of the following user-configurable operations:
 - Generates a system reset †
 - Generates an interrupt, restarts the timer, and if the timer is not cleared before a second timeout occurs, generates a system reset
- Dual programmable timeout period, used when the time to wait after the first start is different than that required for subsequent restarts †
- Prevention of accidental restart of the watchdog counter †
- Prevention of accidental disabling of the watchdog counter †
- Pause mode for debugging

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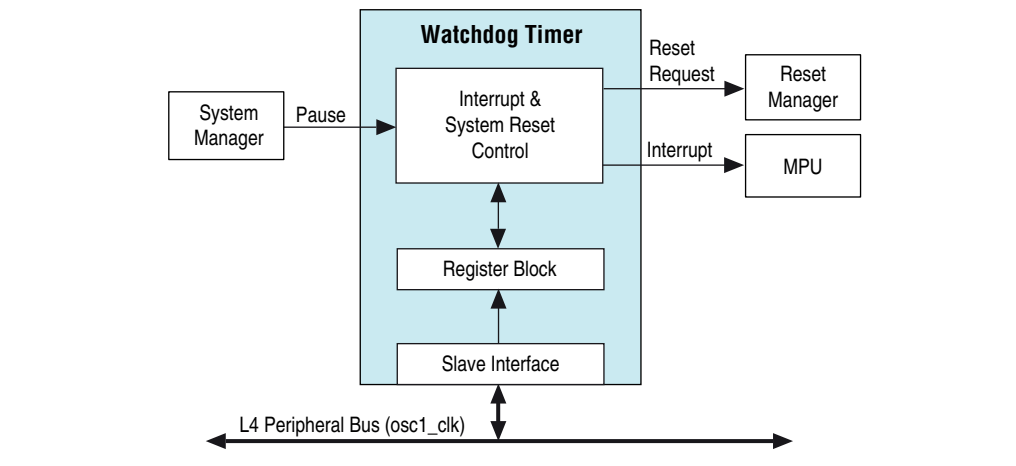
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Watchdog Timer Block Diagram and System Integration

Figure 24-1 shows a block diagram of the watchdog timer.

Figure 24-1. Watchdog Timer Block Diagram



Each watchdog timer consists of a slave interface for control and status register (CSR) access, a register block, and a 32-bit down counter that operates on the slave interface clock (*osc1_clk*). A pause input, driven by the system manager, optionally pauses the counter when a CPU is being debugged.

The watchdog timer drives an interrupt request to the MPU and a reset request to the reset manager.



For more information, refer to the *Cortex-A9 MPU System* and *Reset Manager* chapters in volume 3 of the *Cyclone V Device Handbook*.

Functional Description of the Watchdog Timer

The watchdog timers are peripherals that can be used to recover from system lockup typically caused by software or system related issues.

Counter

Each watchdog timer is a programmable down counter that decrements by one on each clock cycle. The watchdog timer supports 16 fixed timeout period values and software chooses which timeout periods are desired. A timeout period is 2^n *osc1_clk* clock periods, where n is an integer from 16 to 31 inclusive. For information about programming the timeout period values, refer to “[Setting the Timeout Period Values](#)” on page 24-4. For more information about the *osc1_clk* clock, refer to “[Clocks](#)” on page 24-3.

If the counter reaches zero, the watchdog timer has timed out, indicating an unrecoverable error has occurred and a system reset is needed. Software must continually restart the timer (which reloads the counter with the restart timeout period value) to indicate that the system is functioning normally. Software can reload the counter at any time by writing to the restart register. For information, refer to [“Reloading a Watchdog Counter” on page 24-4](#).

Software sets the watchdog timer output response mode to either generate a reset request on a timeout, or assert an interrupt request and start counting down a second time. In the former case, the counter wraps and keeps decrementing, even while a reset request is asserted, until the watchdog timer is reset by the reset manager. In the latter case, the generated interrupt is passed to the generic interrupt controller (GIC) in the MPU subsystem. If the interrupt is not serviced by software before a second timeout occurs, the timer generates a reset request. For information about programming the output response mode, refer to [“Selecting the Output Response Mode” on page 24-4](#).



If a restart occurs at the same time the watchdog counter reaches zero, an interrupt is not generated.

Pause Mode

The watchdog timers can be paused during debugging. Pausing the watchdog timers is controlled by the system manager. The following options are available:

- Pause the timer while either CPU0 or CPU1 is in debug mode
- Pause the timer while only CPU1 is in debug mode
- Pause the timer while only CPU0 is in debug mode
- Do not pause the timer

When pause mode is enabled, the system manager pauses the watchdog timer while debugging. When pause mode is disabled, the watchdog timer runs even while debugging.

When the system manager exits reset, the watchdog pausing feature is enabled for both CPUs by default.

For information about programming the pause mode, refer to [“Pausing a Watchdog Timer” on page 24-5](#).

Clocks

Each watchdog timer is connected to the `osc1_clk` clock so that timer operation is not dependent on the phase-locked loops (PLLs) in the clock manager. This independence allows recovery from software that inadvertently programs the PLLs in the clock manager incorrectly.



For more information, refer to the [Clock Manager](#) chapter in volume 3 of the *Cyclone V Device Handbook*.

Resets

Watchdog timers are reset by a cold or warm reset from the reset manager, and are disabled when exiting reset. †



For more information, refer to the *Reset Manager* chapter in volume 3 of the *Cyclone V Device Handbook*.

Watchdog Timer Programming Model

The watchdog timer is a little-endian module. This section describes the programming options for the timers.

Setting the Timeout Period Values

The watchdog timers have a dual timeout period. The counter uses the initial start timeout period value the first the timer is started. All subsequent restarts use the restart timeout period. The valid values are $2^{(16+i)} - 1$ clock cycles, where i is an integer from 0 to 15. To set the programmable timeout periods, perform the following steps:

- To set the initial start timeout period, write i to the timeout period for initialization field (`top_init`) of the watchdog timeout range register (`wdt_torr`).
- To set the restart timeout period, write i to the timeout period field (`top`) of the `wdt_torr` register.



Set the timeout values before enabling the timer.

Selecting the Output Response Mode

The watchdog timers have two output response modes (as described in “Counter” on page 24-2). To select the desired mode, perform one of the following steps:

- To generate a system reset request when a timeout occurs, write 0 to the output response mode bit (`rmod`) of the watchdog timer control register (`wdt_cr`).
- To generate an interrupt and restart the timer when a timeout occurs, write 1 to the `rmod` field of the `wdt_cr` register.

If a restart occurs at the same time the watchdog counter reaches zero, a system reset is not generated. †

Enabling and Initially Starting a Watchdog Timer

To enable and start a watchdog timer, write the value 1 to the watchdog timer enable bit (`wdt_en`) of the `wdt_cr` register.

Reloading a Watchdog Counter

To reload a watchdog counter, write the value 0x76 to the counter restart register (`wdt_crr`). This unique 8-bit value is used as a safety feature to prevent accidental restarts.

Pausing a Watchdog Timer

Pausing the watchdog timers is controlled by the L4 watchdog debug register (wddb9) in the system manager.

For more information, refer to register definitions section of the *System Manager* chapter in volume 3 of the *Cyclone V Device Handbook*.

Disabling and Stopping a Watchdog Timer

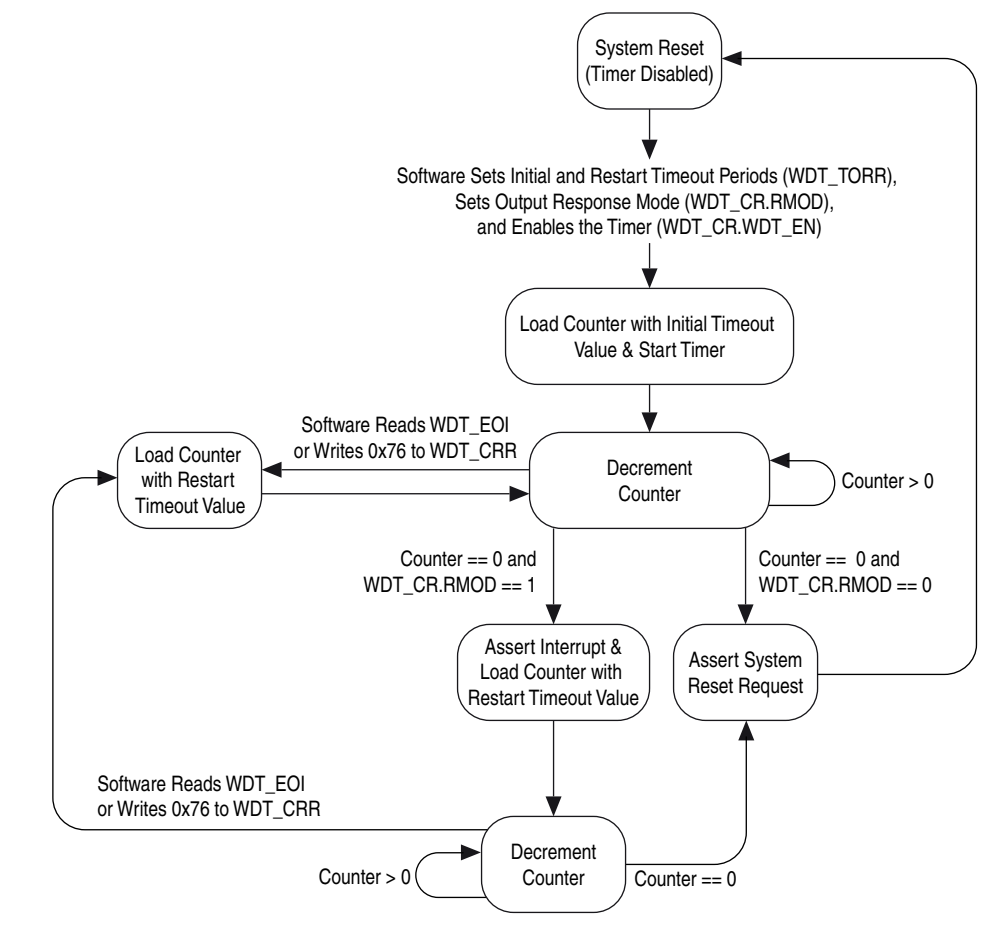
The watchdog timers are disabled and stopped only by resetting them from the reset manager.

For more information, refer to the *Reset Manager* chapter in volume 3 of the *Cyclone V Device Handbook*.

Watchdog Timer State Machine

Figure 24-2 shows a state machine for the watchdog timer functionality.

Figure 24-2. Watchdog Timer State Machine



The state machine illustrates the behavior of the watchdog timer, including the behavior of both output response modes. Once initialized, the counter decrements at every clock cycle. The state machine remains in the Decrement Counter state until the counter reaches zero, or the watchdog timer is restarted. If software reads the interrupt clear register (`wdt_eoi`), or writes 0x76 to the `wdt_crr` register, the state changes from Decrement Counter to Load Counter with Restart Timeout Value. In this state, the watchdog counter gets reloaded with the restart timeout value, and then the state changes back to Decrement Counter.

If the counter reaches zero, the state changes based on the value of the output response mode setting defined in the `rmod` bit of the `wdt_cr` register. If the `rmod` bit of the `wdt_cr` register is 0, the output response mode is to generate a system reset request. In this case, the state changes to Assert System Reset Request. In response, the reset manager resets and disables the watchdog timer, and gives software the opportunity to reinitialize the timer.

If the `rmod` bit of the `wdt_cr` register is 1, the output response mode is to generate an interrupt. In this case, the state changes to Assert Interrupt and Load Counter with Restart Timeout Value. An interrupt to the processor is generated, and the watchdog counter is reloaded with the restart timeout value. The state then changes to the second Decrement Counter state, and the counter resumes decrementing. If software reads the `wdt_eoi` register, or writes 0x76 to the `wdt_crr` register, the state changes from Decrement Counter to Load Counter with Restart Timeout Value. In this state, the watchdog counter gets reloaded with the restart timeout value, and then the state changes back to the first Decrement Counter state. If the counter again reaches zero, the state changes to Assert System Reset Request. In response, the reset manager resets the watchdog timer, and gives software the opportunity to reinitialize the timer.

Watchdog Timer Address Map and Register Definitions



The address map and register definitions reside in the [hps.html](#) file that accompanies this handbook volume. Click the link to open the file.

To view the module description and base address, scroll to and click the link for either of the following module instances:

- **l4wd0**
- **l4wd1**

To then view the register and field descriptions, scroll to and click the register names. The register addresses are offsets relative to the base address of each module instance.



The base addresses of all modules are also listed in the *Introduction to the Hard Processor System* chapter in volume 3 of the *Cyclone V Device Handbook*.

Document Revision History

Table 24-1 shows the revision history for this document.

Table 24-1. Document Revision History

Date	Version	Changes
November 2012	1.2	Minor updates.
May 2012	1.1	Added programming model and address map and register definitions sections.
January 2012	1.0	Initial release.

The hardware processor system (HPS) provides two controller area network (CAN) controllers for serial communication with the Cortex™-A9 microprocessor unit (MPU) subsystem host processor and the direct memory access (DMA) controller using the CAN protocol. The CAN controllers are instances of the Bosch® D_CAN controller and compliant with ISO 11898-1.

Features of the CAN Controller

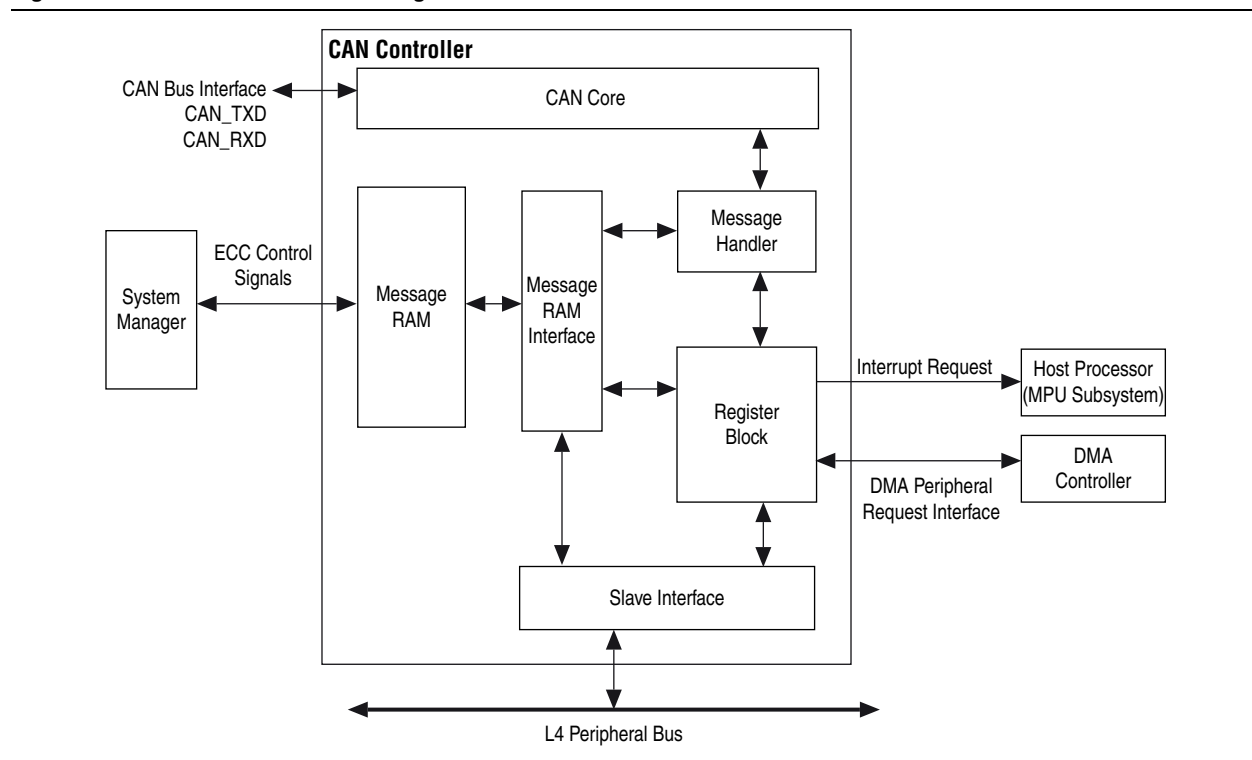
The CAN controllers offer the following features:

- Compliant with *CAN Protocol Specification 2.0* parts A and B, available from the Bosch website (www.semiconductors.bosch.de)
- Programmable communication rate up to 1 Mbps
- Holds up to 128 messages
- Error correction code (ECC)
- 11-bit standard and 29-bit extended identifiers
- Programmable loopback mode
- External direct memory access (DMA) controller for large data transfers
- Automatic retransmission

CAN Controller Block Diagram and System Integration

Figure 25-1 shows the CAN controller block diagram.

Figure 25-1. CAN Controller Block Diagram



The CAN controller consists of the following modules and interfaces:

- CAN core
 - Connects to the CAN bus interface
 - Handles all ISO 11898-1 protocol functions
- Message handler
 - State machine that controls the data transfer between the message RAM and CAN core.
 - Handles acceptance filtering and the interrupt generation
- Message RAM
 - Storage for up to 128 messages objects
 - Single bit error correction and double bit error detection
- Message RAM interface
 - Two separate interfaces, IF1 and IF2

- Register block
 - Control and status registers (CSR) for module setup and indirect message object access.
 - All host processor accesses to the message RAM are relayed through the message RAM interface.
- Level 4 (L4) slave interface for CSR accesses

Functional Description of the CAN Controller

The CAN controllers perform communication according to the CAN protocol version 2.0 parts A and B. All communication on the CAN bus is through message objects. The CAN controller stores message objects in its internal message RAM. The host processor cannot access the message RAM directly, instead the IF1 and IF2 message interface register sets provide the host processor access to the messages. Messages are passed between the message RAM and the CAN core by the message handler. The message handler is also responsible for message level responsibilities such as acceptance filtering, interrupt generation, and transmission request generation.

Message Object

The message RAM can store up to 128 message objects. To avoid conflicts between host processor accesses to the message RAM and CAN message reception and transmission, the host processor does not access the message objects directly. Accesses are handled through the IF1 and IF2 message interface registers.

Table 25–1 shows the structure of a message object. The first row contains the message object control flags, the second row contains the message object masks, and the third row is the CAN message.

Table 25–1. Message Object Structure

MsgVal				NewDat	MsgLst	IntPnd		TxIE	RxIE	RmtEn	TxRqst	EoB
UMask	Msk [28:0]	MXtd	MDir									
	ID [28:0]	Xtd	Dir	DLC [3:0]	Data 0 [7:0]	Data 1 [7:0]	Data 2 [7:0]	Data 3 [7:0]	Data 4 [7:0]	Data 5 [7:0]	Data 6 [7:0]	Data 7 [7:0]

Message Object Control Flags

This section describes the message object control flags.

Message Valid (MsgVal)

- 0= The message object is ignored by the message handler
- 1= The message object is configured and should be considered by the message handler

The host processor must set the MsgVal bit of all unused message objects to 0 before it resets the initialization bit (Init) of the CAN control register (CTRL) to initialize the CAN controller. MsgVal must also be set to 0 when the message object is no longer in use.

The `MsgVal` field is directly readable from the message valid registers (`MOVALA`, `MOVALB`, `MOVALC`, `MOVALD`, and `MOVALX`). However, to write to the `MsgVal` field for a specific message object, the host processor must write to the message interface registers.

New Data (`NewDat`)

- 0= No new data has been written into the data portion of this message object by the message handler since last time this flag was cleared by the host processor.
- 1= The message handler or the host processor has written new data to the data portion of this message object.

The `NewDat` field is directly readable from the new data registers (`MONDA`, `MONDB`, `MONDC`, `MONDD`, and `MONDX`). However, to write to the `NewDat` field for a specific message object, the host processor must write to the message interface registers.

Message Lost (`MsgLst`)

- 0= No message lost since last time this bit was last reset by the host processor
- 1= The message handler stored a new message into this object when the `NewDat` bit was still set, indicating the host processor has lost a message.

`MsgLst` is valid only in message objects with the message direction bit (`Dir`) set to receive.

Interrupt Pending (`IntPnd`)

- 0= This message object is not the source of an interrupt.
- 1= This message object is the source of an interrupt. The interrupt identifier field in the CAN interrupt register (`CIR`) points to this message object if there is no other interrupt source with higher priority.

The `IntPnd` field is directly readable from the interrupt pending registers (`MOIPA`, `MOIPB`, `MOIPC`, `MOIPD`, and `MOIPX`). However, to write to the `IntPnd` field for a specific message object, the host processor must write to the message interface registers.

Transmit Interrupt Enable (`TxIE`)

- 0= `TxIE` is disabled. `IntPnd` is left unchanged after the successful transmission of a frame.
- 1= `TxIE` is enabled. `IntPnd` is set after a successful transmission of a frame.

Receive Interrupt Enable (`RxIE`)

- 0= `RxIE` is disabled. `IntPnd` is left unchanged after a successful reception of a frame.
- 1= `RxIE` is enabled. `IntPnd` is set after a successful reception of a frame.

Remote Enable (`RmtEn`)

- 0= `RmtEn` is disabled. At the reception of a remote frame, `TxRqst` is left unchanged.
- 1= `RmtEn` is enabled. At the reception of a remote frame, `TxRqst` is set.

Transmit Request (`TxRqst`)

- 0= This message object is not waiting for transmission.

- 1= The transmission of this message object is requested and is not complete.

The TxRqst field is directly readable from the transmission request registers (MOTRA, MOTRB, MOTRC, MOTRD, and MOTRX). However, to write to the TxRqst field for a specific message object, the host processor must write to the message interface registers.

End of Block (EoB)

- 0= Message object belongs to a FIFO buffer block and is not the last message object of that FIFO buffer block.
- 1= Single message object or last message object of a FIFO buffer block.

This bit is used to concatenate two or more message objects (up to 128) to build a FIFO buffer. For single message objects (not belonging to a FIFO buffer), this bit must always be set to 1.

Message Object Mask Bits

The message object mask bits, together with the arbitration bits, are used for acceptance filtering of incoming messages.

Use Acceptance Mask (UMask)

- 0= Ignore mask. Msk[28:0], MXtd, and MDir have no effect on acceptance filtering. For an incoming message to be accepted, all the following conditions must be met:
 - The received message is a data frame with message direction set to 0 (receive) or is a remote frame with message direction set to 1 (transmit).
 - The received message identifier matches the message identifier (ID[28:0]) of the message object.
 - The received identifier extension bit matches the identifier extension bit (Xtd) of the message object.
- 1= Use mask (Msk[28:0], MXtd, and MDir) for acceptance filtering if the respective mask bits are set up for acceptance filtering. For an incoming message to be accepted, all the following conditions must be met:
 - The received message is a data frame with message direction set to 0 (receive) or is a remote frame with message direction set to 1 (transmit) with the MDir mask bit enabled.
 - The received message identifier matches the message identifier (ID[28:0]) of the message object with the Msk[28:0] mask bits enabled
 - The received identifier extension bit matches the identifier extension bit (Xtd) of the message object, with the MXtd mask bit enabled.



If the UMask bit is set to 1, the message object's mask bits have to be programmed during the initialization of the message object before MsgVal is set to 1.

Identifier Mask (Msk[28:0])

The identifier mask filters the corresponding bits in ID[28:0].

- 0= The corresponding identifier bit has no effect on the acceptance filter.
- 1= The corresponding identifier bit is used for acceptance filtering.

Extended Identifier Mask (MXtd)

- 0= The extended frame identifier bit (Xtd) has no effect on the acceptance filtering
- 1= The extended frame identifier bit (Xtd) is used for acceptance filtering

When 11-bit (standard) identifiers are used for a message object, the identifiers of received data frames are written to bits ID28 to ID18. For acceptance filtering, only these bits, together with mask bits Msk28 to Msk18, are used.

Mask Message Direction (MDir)

- 0= The message direction bit (Dir) has no effect on the acceptance filtering.
- 1= The message direction bit (Dir) is used for acceptance filtering.

(1) Altera recommends always setting MDir to 1. Ignoring the message direction bit is an advanced technique that must be handled with great care.

CAN Message Bits

The arbitration fields ID28-0, Xtd, and Dir are used to define the identifier and type of outgoing messages and are used (together with the mask fields Msk28-0, MXtd, and MDir) for acceptance filtering of incoming messages. A received message is stored to the valid message object with matching identifier when the direction is set to receive a data frame or transmit a remote frame. Extended frames can be stored only in message objects with Xtd is set to 1, standard frames in message objects with Xtd is set to 0. If a received message (data frame or remote frame) matches more than one valid message object, it is stored to the object with the lowest message number.

Message Identifier (ID[28:0])

- ID28-ID0: 29-bit identifier (extended frame)
- ID28-ID18: 11-bit identifier (standard frame)

Extended Frame Identifier (Xtd)

- 0= The 11-bit (standard) identifier is used for this message object.
- 1= The 29-bit (extended) identifier is used for this message object.

Message Direction (Dir)

- 0= receive direction. When TxRqst is set to 1, a remote frame with the identifier of this message object is transmitted. On reception of a data frame with matching identifier, that message is stored in this message object.
- 1= transmit direction. When TxRqst is set to 1, the respective message object is transmitted as a data frame. On reception of a remote frame with matching identifier, the TxRqst bit of this message object is set to 1 (if RmtEn = 1).

Data Length Code (DLC[3:0])

DLC specifies the number of data bytes in the data frame. The maximum number is eight.

The data length code (DLC) of a message object must be defined the same as in all the corresponding objects with the same identifier in all CAN devices. When the message handler stores a data frame, it sets the DLC field to the value provided in the received message.

Data Bytes 0-7 (Data 0[7:0] - Data 7[7:0])

The data bytes in a CAN data frame.

Message Interface Registers

There are two sets of message interface registers, IF1 and IF2, that provide a means for a host processor or DMA controller to access any message object indirectly. Message objects are transferred between the message RAM and the message buffer registers as a single, atomic operation maintaining data consistency across the message.

Table 25-2 lists the structure of each message interface register set, where *x* represents either set 1 or set 2.

Table 25-2. Message Interface Register Set

Register Type	Register	Name	Description
Command	IFxCMR	IFx command register	Specifies the transfer direction and selects the portions of the message object to transfer
Message buffer	IFxMSK	IFx mask register	Provides access to the Msk, MDir, and MXtd mask fields of the message object
	IFxARB	IFx arbitration register	Provides access to the ID, Dir, Xtd, and MsgVal arbitration fields of the message object
	IFxMCTR	IFx message control register	Provides access to the DLC, EoB, TxRqst, RmtEn, RxIE, TxIE, UMask, IntPnd, MsgLst, and NewDat fields of the message object
	IFxDA	IFx data A register	Provides access to data bytes 0-3 of the message object
	IFxDB	IFx data B register	Provides access to data bytes 4-7 of the message object

DMA Mode

The CAN controller, shown in Figure 25-1, can issue DMA controller requests to transfer data between one or both of the message interface registers and system memory. The CAN controller has two DMA request interfaces, called `can_if1dma` and `can_if2dma`. The CAN peripheral request interfaces are shared with the FPGA DMA peripheral request interfaces. To use the DMA peripheral request interface, the host processor must access the CAN control register (CTRL) in the protocol group (`protogrp`). The peripheral request interface is selected through the system manager.



For more information about the selecting the CAN DMA peripheral request interface, refer to the *System Manager* chapter in volume 3 of the *Cyclone V Device Handbook*.

To activate the DMA support feature and initiate a transfer, write a 1 to the DMAactive bit in the appropriate IF command register (IFxCMR) in the message interface group (`msgifgrp`). After the message object transfer is completed, the CAN controller issues a DMA peripheral request to perform the next message object transfer. The request remains active until the first read or write to the message interface register.



For more information, refer to the *DMA Controller* chapter in volume 3 of the *Cyclone V Device Handbook*.

Automatic Retransmission

The CAN controller provides a means for automatic retransmission of frames that have lost arbitration or have errors during transmission. Retransmission happens automatically without user intervention or notification. Normal confirmation is given when the transmission is successfully complete.

Test Mode

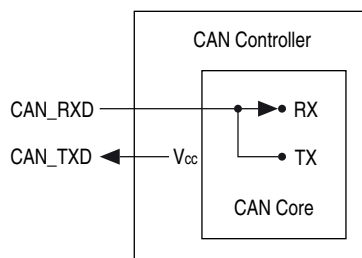
To enable test mode, set the test mode enable bit (Test) in the CCTRL register to 1. This action activates write access to the CAN test register (CTR). The following sections describe the available test modes.

Silent Mode

The CAN controller is set in the silent mode by programming the silent mode (Silent) bit in the test register (CTR) to 1. In silent mode, the CAN controller is able to receive valid data frames and valid remote frames, but it holds the CAN_TXD pin high, sending no data to the CAN bus. The silent mode can be used to analyze the traffic on a CAN bus without affecting it by the transmission of dominant bits (acknowledge bits, error frames). In ISO 11898-1, the silent mode is called the *bus monitoring mode*.

Figure 25-2 shows the CAN core in silent mode.

Figure 25-2. CAN Core in Silent Mode



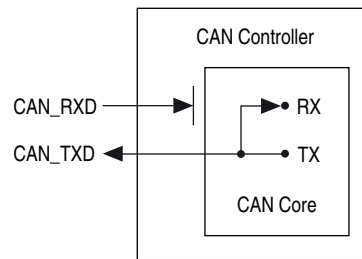
Loopback Mode

The CAN controller is set in loopback mode by programming the loopback mode (LBack) bit in the test register (CTR) to 1. In loopback mode, the CAN controller treats its own transmitted messages as received messages and stores them (if they pass acceptance filtering) to a receive buffer.

To be independent from external stimulation, the CAN controller ignores acknowledge errors in loopback mode. In this mode, the CAN controller provides internal feedback from its transmit (TX) output to its receive (RX) input. The actual value of the input pin is disregarded by the CAN controller.

Figure 25-3 shows the CAN core in loopback mode.

Figure 25-3. CAN Core in Loopback Mode

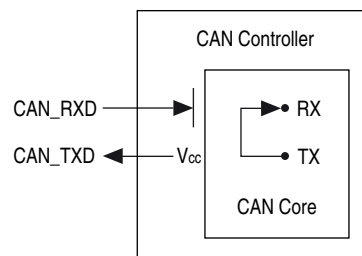


Combined Mode

The CAN controller is set in combined loopback and silent mode by programming the silent mode (Silent) and loopback mode (LBack) bits in the test register (CTR) to 1. Combined mode can be used for testing the CAN hardware without affecting other devices connected to the CAN bus. In this mode, the CAN_RXD pin is disconnected from the CAN core and the CAN_TXD pin is held high.

Figure 25-4 shows the CAN core in combined mode.

Figure 25-4. CAN Core in Combined Mode



L4 Slave Interface

The host processor accesses data, control, and status information of the CAN controller through the L4 slave interface. The slave interface supports 32-bit accesses only.



This interface does not support error responses.

Clocks

The CAN controller operates on the `l4_sp_clk` and `can_clk` clock inputs. The `l4_sp_clk` clock is used by the L4 slave interface and the `can_clk` is used to operate the CAN core.

The `can_clk` clock must be programmed to be at least eight times the CAN bus interface speed. For example, for a CAN bus interface operating at a 1 Mbps baud rate, the `can_clk` clock must be set to at least 8 MHz. The `l4_sp_clk` clock can operate at a clock frequency that is equal to or greater than the `can_clk` frequency.



For more information about the `l4_sp_clk` and `can_clk` clocks, refer to the *Clock Manager* chapter in volume 3 of the *Cyclone V Device Handbook*.

Resets

Each CAN controller can be reset by software or by hardware.

Software Reset

Software initialization is done by setting the `Init` bit in the CAN control register (CCTRL) in the protocol group (protogrp) in the CAN controller register map. This bit is set through the CAN protocol when a bus off condition occurs on the CAN link. The bit is also set through the hardware reset input described in “*Hardware Reset*”.



Due to the synchronization mechanism between the two clock domains, there might be a delay until the value written to the `Init` bit can be read back. To assure that the previous value written has been accepted, read the `Init` bit before setting it to a new value.



The bus off recovery sequence cannot be shortened by setting or resetting the `Init` bit. For more information about bus off, refer to the *CAN Protocol Specification 2.0* parts A and B, available from the Bosch website (www.semiconductors.bosch.de).

Hardware Reset

Each CAN controller has a separate reset signal. The reset manager drives the signals on a cold or warm reset. The reset signal is synchronized to both clock domains and applied to the appropriate logic within the CAN controllers.



For more information, refer to the *Reset Manager* chapter in volume 3 of the *Cyclone V Device Handbook*.

Interrupts

Each CAN controller generates two interrupt signals. One signal indicates error and status interrupts and the other signal indicates message object interrupts. Both interrupt signals connect to the global interrupt controller (GIC). Interrupts are enabled in the CAN control register (CCTRL) in the protocol group (protogrp). The CAN interrupt register (CIR) in the protocol group (protogrp) indicates the highest priority interrupt that is pending.

Error Interrupts

The following error conditions generate interrupts:

- Bus off—when the transmit error count is equal to or greater than 256, the bus off (BOff) bit in the CAN status register (CSTS) in the protocol group (protogrp) is set to 1.
- Error warning—when either the transmit error counter or the receive error counters reaches 96, the error warning status (EWarn) bit in the CAN status register (CSTS) in the protocol group (protogrp) is set to 1.

Status Interrupts

The following status conditions generate interrupts:

- Receive OK—when the CAN controller receives a message successfully, the RxOK bit in the CAN status register (CSTS) in the protocol group (protogrp) is set to 1.
- Transmit OK—when the CAN controller transmits a message successfully, the TxOK bit in the CAN status register (CSTS) in the protocol group (protogrp) is set to 1.
- Last error code—when a message is received or transmitted with an error, the LEC bits in the CAN status register (CSTS) in the protocol group (protogrp) are set according to the error type.

Message Object Interrupts

The IntPnd bits from the message objects can generate interrupts when the corresponding message object TxIE bit or RxIE bit is set to 1. Table 25-2 lists the location of message object interrupt information in the interrupt pending registers. The interrupt pending registers are located in the message handler group (msghandgrp).

Table 25-3. Message Object Interrupt Registers

Register	Title	Message Objects
MOIPA	Interrupt pending A register	1 to 32
MOIPB	Interrupt pending B register	33 to 64
MOIPC	Interrupt pending C register	65 to 96
MOIPD	Interrupt pending D register	97 to 128

The MOIPX register allows software to quickly detect which message object group has a pending interrupt.

CAN Controller Programming Model

This section describes how to operate the CAN controllers.

Software Initialization

The software initialization is started by setting the Init bit in the CAN control register (CCTRL) to 1. While the Init bit is 1, messages are not transferred to or from the CAN bus, and the CAN_TXD CAN bus output is held in the high state. Setting the Init bit does not change any configuration registers.

To initialize the CAN controller, the host processor must program the CAN bit timing (CBT) register and message objects that will be used for CAN communication. If a message object is not needed, it is sufficient to set the MsgVal bit of the message object to not valid (0), which is the default after RAM initialization. You must set up the entire message object before setting MsgVal bit to valid (1). The message objects are set up through either message interface register set.

Access to the CAN bit timing (CBT) register is only enabled when the configuration change enable (CCE) and Init bits in the CAN control register (CCTRL) are both set to 1.

Setting the `Init` bit to 0 finishes the software initialization. The CAN core synchronizes itself to the data transfer on the CAN bus by waiting for the bus to reach an idle state before it can take part in bus activities and message transfers.

The initialization of the message objects is independent of the CAN controller initialization and can be done anytime, but the message objects should all be configured to particular identifiers or set to not valid before message transferring begins.

On power up, the message RAM has to be initialized. To initialize RAM, set the `Init` bit to 1, then set the `RAMInit` bit in the CAN function register (CFR) in the protocol group (`protogrp`) to 1. The `RAMInit` bit returns to 0 when RAM initialization completes. During RAM initialization, all message objects are cleared to zero and the RAM ECC bits are initialized. Access to RAM is not allowed prior to or during RAM initialization.

CAN Message Transfer

Once the CAN controller is initialized, the CAN controller synchronizes itself to the CAN bus and starts transferring messages.

Received messages are stored to their appropriate message objects, if they pass the message handler's acceptance filtering. The entire message, including all arbitration bits, `Xtd`, `Dir`, `DLC`, eight data bytes, the mask and control bits `UMask`, `MXtd`, `MDir`, `EOB`, `MsgLst`, `RxIE`, `TxIE`, and `RmtEn`, is stored in the message object. Masked arbitration bits might change in the message object when a received message is stored.

The host processor may read or update each message at any time using the message interface registers. The message handler guarantees data consistency when the host processor accesses the message object at the same time the message is being transferred to or from RAM.

Messages to be transmitted are updated by the host processor. If a permanent message object (arbitration and control bits set up during configuration are unchanged for multiple CAN transfers) exists for the message, only the data bytes need to be updated. If several transmit messages are assigned to the same message object (when the number of message objects is not sufficient), the whole message object has to be configured before the transmission of this message is requested.

The transmission of any number of message objects may be requested at the same time they are transmitted, according to their internal priority. The message object numbers are 1 to 128, with 1 being the lowest internal priority and 128 the highest priority. Messages may be updated or set to invalid (`MsgVal=0`) at anytime, even when their requested transmission is still pending. The old data is discarded when a message is updated before its pending transmission has started.

Depending on the configuration on the message object, the transmission of a message may be requested automatically by the reception of a remote frame with a matching identifier. Remote frames are frames used to request a particular message on the CAN network.



For ease in programming, Altera recommends using one IF message interface for all receive direction activity and the other IF message interface for all transmit direction activity.

Message Object Reconfiguration for Frame Reception

To configure a message object to receive data frames, set the `Dir` field to 0.

To configure a message object to receive remote frames, set the `Dir` field to 1, set `UMask` to 1, and set `RmtEn` to 0.

To avoid modifying an object while it is being transmitted, you must set `MsgVal` to 0 before changing any of the following configuration and control bits:

- `ID[28:0]`
- `Xtd`
- `DLC[3:0]`
- `RxIE`
- `TxIE`
- `RmtEn`
- `EoB`
- `UMask`
- `Msk[28:0]`
- `MXtd`
- `MDir`

The following fields of a message object can be changed without clearing `MsgVal`:

- `Data0[7:0]` to `Data7[7:0]`
- `TxRqst`
- `NewDat`
- `MsgLst`
- `IntPnd`

Message Object Reconfiguration for Frame Transmission

To configure a message object to transmit data frames, set the `Dir` field to 1, and either set `UMask` to 0 or set `RmtEn` to 1.

Before changing any of the following configuration and control bits, you must set `MsgVal` to 0:


- `Dir`
- `RxIE`
- `TxIE`
- `RmtEn`
- `EoB`
- `UMask`
- `Msk[28:0]`

- MXtd
- MDir

The following fields of a message object can be changed without clearing MsgVal:

- ID[28:0]
- Xtd
- DLC[3:0]
- Data0[7:0] to Data7[7:0]
- TxRqst
- NewDat
- MsgLst
- IntPnd


CAN Controller Address Map and Register Definitions

 The address map and register definitions reside in the [hps.html](#) file that accompanies this handbook volume. Click the link to open the file.

To view the module description and base address, scroll to and click the link for either of the following module instances:

- **can0**
- **can1**

To then view the register and field descriptions, scroll to and click the register names. The register addresses are offsets relative to the base address of each module instance.

 The base addresses of all modules are also listed in the *Introduction to the Hard Processor System* chapter in volume 3 of the *Cyclone V Device Handbook*.

Document Revision History

Table 25–4 shows the revision history for this document.

Table 25–4. Document Revision History

Date	Version	Changes
November 2012	1.2	<ul style="list-style-type: none"> ■ Minor updates. ■ Expanded reset section. ■ Expanded interrupts section.
May 2012	1.1	Added block diagram and system integration, functional description, programming model, and address map and register definitions sections.
January 2012	1.0	Initial release.

This section includes the following chapters:

- Chapter 26, Introduction to the HPS Component
- Chapter 27, Instantiating the HPS Component
- Chapter 28, HPS Component Interfaces
- Chapter 29, Simulating the HPS Component



For information about the revision history for chapters in this section, refer to “Document Revision History” in each individual chapter.

The hard processor system (HPS) component is a soft component that you can instantiate in the FPGA fabric of the Cyclone® V SoC FPGA. It enables other soft components to interface with the HPS hard logic. The HPS component itself has a small footprint in the FPGA fabric, because its only purpose is to enable soft logic to connect to the extensive hard logic in the HPS.

- 

For a description of the HPS and its integration into the system on a chip (SoC), refer to the *Cyclone V Device Datasheet*. For a description of HPS system architecture and features, refer to the *Introduction to the Hard Processor* chapter in volume 3 of the *Cyclone V Device Handbook* and the *CoreSight Debug and Trace* chapter in volume 3 of the *Cyclone V Device Handbook*.
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For descriptions of individual peripheral architectures and features, refer to the following chapters and sections:

 - “HPS Block Diagram and System Integration” in the *Introduction to the Hard Processor* chapter in volume 3 of the *Cyclone V Device Handbook*.
 - “Clock Manager Block Diagram and System Integration” in the *Clock Manager* chapter in volume 3 of the *Cyclone V Device Handbook*.
 - “Reset Manager Block Diagram and System Integration” in the *Reset Manager* chapter in volume 3 of the *Cyclone V Device Handbook*.
 - “Interconnect Block Diagram and System Integration” in the *Interconnect* chapter in volume 3 of the *Cyclone V Device Handbook*.
 - “AXI Bridges Block Diagrams and System Integration” in the *HPS-FPGA AXI Bridges* chapter in volume 3 of the *Cyclone V Device Handbook*.
 - “Cortex-A9 MPU Subsystem Block Diagram and System Integration” in the *Cortex-A9 Microprocessor Unit Subsystem* chapter in volume 3 of the *Cyclone V Device Handbook*.
 - “CoreSight Debug and Trace Block Diagram and System Integration” in the *CoreSight Debug and Trace* chapter in volume 3 of the *Cyclone V Device Handbook*.
 - “SDRAM Controller Subsystem Block Diagram and System Integration” in the *SDRAM Controller Subsystem* chapter in volume 3 of the *Cyclone V Device Handbook*.
 - “On-Chip RAM Block Diagram and System Integration” in the *On-Chip Memory* chapter in volume 3 of the *Cyclone V Device Handbook*.
 - “Boot ROM Block Diagram and System Integration” in the *On-Chip Memory* chapter in volume 3 of the *Cyclone V Device Handbook*.

- “NAND Flash Controller Block Diagram and System Integration” in the *NAND Flash Controller* chapter in volume 3 of the *Cyclone V Device Handbook*.
- “SD/MMC Controller Block Diagram and System Integration” in the *SD/MMC Controller* chapter in volume 3 of the *Cyclone V Device Handbook*.
- “Quad SPI Flash Controller Block Diagram and System Integration” in the *Quad SPI Flash Controller* chapter in volume 3 of the *Cyclone V Device Handbook*.
- “FPGA Manager Block Diagram and System Integration” in the *FPGA Manager* chapter in volume 3 of the *Cyclone V Device Handbook*.
- “System Manager Block Diagram and System Integration” in the *System Manager* chapter in volume 3 of the *Cyclone V Device Handbook*.
- “Scan Manager Block Diagram and System Integration” in the *Scan Manager* chapter in volume 3 of the *Cyclone V Device Handbook*.
- “DMA Controller Block Diagram and System Integration” in the *DMA Controller* chapter in volume 3 of the *Cyclone V Device Handbook*.
- “EMAC Block Diagram and System Integration” in the *Ethernet Media Access Controller* chapter in volume 3 of the *Cyclone V Device Handbook*.
- “USB OTG Controller Block Diagram and System Integration” in the *USB 2.0 OTG Controller* chapter in volume 3 of the *Cyclone V Device Handbook*.
- “SPI Block Diagram and System Integration” in the *SPI Controller* chapter in volume 3 of the *Cyclone V Device Handbook*.
- “I²C Controller Block Diagram and System Integration” in the *I²C Controller* chapter in volume 3 of the *Cyclone V Device Handbook*.
- “UART Controller Block Diagram and System Integration” in the *UART Controller* chapter in volume 3 of the *Cyclone V Device Handbook*.
- “General-Purpose I/O Interface Block Diagram and System Integration” in the *General-Purpose I/O Interface* chapter in volume 3 of the *Cyclone V Device Handbook*.
- “Timer Block Diagram and System Integration” in the *Timer* chapter in volume 3 of the *Cyclone V Device Handbook*.
- “Watchdog Timer Block Diagram and System Integration” in the *Watchdog Timer* chapter in volume 3 of the *Cyclone V Device Handbook*.
- “CAN Controller Block Diagram and System Integration” in the *CAN Controller* chapter in volume 3 of the *Cyclone V Device Handbook*.



The address map and register definitions reside in the [hps.html](#) file that accompanies this handbook volume. Click the link to open the file.

To view the description and base address for a specific peripheral, scroll to and click the link for the peripheral’s module name.

To then view the register and field descriptions, scroll to and click the register names. The register addresses are offsets relative to the base address of each module instance.



Document Revision History

Table 26–1 shows the revision history for this document.

Table 26–1. Document Revision History


Date	Version	Changes
June 2012	1.0	Initial release.
May 2012	0.1	Preliminary draft.

You instantiate the hard processor system (HPS) component in Qsys. The HPS is available in the component library under **Embedded Processors**. This chapter describes the parameters available in the HPS component parameter editor, which opens when you add or edit an HPS component.

-  The HPS requires specific device targets. For a detailed list of supported devices, refer to the *Cyclone® V Device Datasheet*.
-  For general information about using Qsys, refer to the *Creating a System with Qsys* chapter in volume 1 of the *Quartus® II Handbook*.

Configuring FPGA Interfaces

This section describes parameters on the **FPGA Interfaces** tab.

-  For general information about interfaces, refer to the *HPS Component Interfaces* chapter in volume 3 of the *Cyclone V Device Handbook*.

General Interfaces

This section describes parameters in the **General** group on the **FPGA Interfaces** tab. When enabled, the interfaces described in [Table 27-1](#) become visible in the HPS component.

Table 27-1. General Parameters

Parameter Name	Parameter Description	Interface Name
Enable MPU standby and event signals	Enables interfaces that perform the following functions: <ul style="list-style-type: none"> ■ Notify the FPGA fabric that the microprocessor unit (MPU) is in standby mode. ■ Wake up an MPCore processor from a wait for event (WFE) state. 	h2f_mpu_events
Enable MPU general purpose signals	Enables a pair of 32-bit unidirectional general-purpose interfaces between the FPGA fabric and the FPGA manager in the HPS portion of the SoC device.	h2f_mpu_gp
Enable FPGA-to-HPS Interrupts	Enables interface for FPGA interrupt signals to the MPU (in the HPS).	f2h_irq0 f2h_irq1
Enable Debug APB interface	Enables debug interface to the FPGA, allowing access to debug components in the HPS. ⁽¹⁾	h2f_debug_apb h2f_debug_apb_sideband h2f_debug_apb_clock
Enable System Trace Macrocell hardware events	Enables system trace macrocell (STM) hardware events, allowing logic inside the FPGA to insert messages into the trace stream. ⁽¹⁾	f2h_stm_hw_events
Enable FPGA Cross Trigger interface	Enables the cross trigger interface (CTI), which allows trigger sources and sinks to interface with the embedded cross trigger (ECT). ⁽¹⁾	h2f_cti h2f_cti_clock
Enable FPGA Trace Port Interface Unit	Enables an interface between the trace port interface unit (TPIU) and logic in the FPGA. The TPIU is a bridge between on-chip trace sources and a trace port. ⁽¹⁾	h2f_tpiu h2f_tpiu_clock_in

Note to Table 27-1:

(1) For information about this functionality, refer to the [CoreSight Debug and Trace](#) chapter in volume 3 of the Cyclone V Device Handbook.


Boot and Clock Selection Interfaces

This section describes parameters in the **Boot and Clock Selection** group in the **FPGA Interfaces** tab.

Table 27-2 lists the available parameters.

Table 27-2. Boot and Clock Selection Parameters

Parameter Name	Parameter Description
Enable boot from FPGA ready	Enables an input to the HPS indicating whether a preloader is available in on-chip RAM. If the input is asserted, a preloader image is ready at memory location 0.
Enable boot from FPGA on failure	Enables an input to the HPS indicating whether a fallback preloader is available in on-chip RAM. If the input is asserted, a fallback preloader image is ready at memory location 0. The fallback preloader is to be used only if the HPS boot ROM does not find a valid preloader image in the selected flash memory device.

 For detailed information about the HPS boot sequence, refer to the *Booting and Configuration* appendix in volume 3 of the *Cyclone V Device Handbook*.

AXI Bridges

This section describes parameters in the **AXI Bridges** group on the **FPGA Interfaces** tab.

Table 27-3. Bridge Parameters

Parameter Name	Parameter Description	Interface Name
FPGA-to-HPS interface width	Enable or disable the FPGA-to-HPS interface; if enabled, set the data width to 32, 64, or 128 bits.	f2h_axi_slave
HPS-to-FPGA interface width	Enable or disable the HPS-to-FPGA interface; if enabled, set the data width to 32, 64, or 128 bits.	h2f_axi_master
Lightweight HPS-to-FPGA interface width	Enable or disable the lightweight HPS-to-FPGA interface. When enabled, the data width is 32 bits.	h2f_lw_axi_master

To facilitate accessing these slaves from a memory-mapped master with a smaller address width, you can use the Altera® Address Span Extender. The address span extender is discussed in “Using the Address Span Extender Component” on page 27-9.

 For more information, refer to the *Interconnect* chapter in volume 3 of the *Cyclone V Device Handbook*.

FPGA-to-HPS SDRAM Interface

This section describes parameters in the **FPGA-to-HPS SDRAM Interface** group on the **FPGA Interfaces** tab.

You can add one or more SDRAM ports that make the HPS SDRAM subsystem accessible to the FPGA fabric.

You can configure the slave interface to a data width of 32, 64, 128, or 256 bits. To facilitate accessing this slave from a memory-mapped master with a smaller address width, you can use the Altera Address Span Extender. The address span extender is discussed in [“Using the Address Span Extender Component” on page 27-9](#).

On the **FPGA Interfaces** tab, in the **FPGA to HPS SDRAM Interface** table, use + or – to add or remove FPGA-to-HPS SDRAM interfaces. The **Name** column denotes the interface name. [Table 27-4](#) shows the parameters available for each SDRAM interface.

Table 27-4. FPGA-to-HPS SDRAM Interface Parameters

Parameter Name	Parameter Description
Name	Port name (auto assigned as shown in Table 27-5)
Type	Interface type: <ul style="list-style-type: none"> ■ AXI-3 ■ Avalon-MM Bidirectional ■ Avalon-MM Write-only ■ Avalon-MM Read-only
Width	32, 64, 128, or 256

Table 27-5. FPGA-to-HPS SDRAM Port and Interface Names

Port Name	Interface Name
f2h_sdram0	f2h_sdram0_data
f2h_sdram1	f2h_sdram1_data
f2h_sdram2	f2h_sdram2_data
f2h_sdram3	f2h_sdram3_data
f2h_sdram4	f2h_sdram4_data
f2h_sdram5	f2h_sdram5_data




For more information, refer to the [SDRAM Controller Subsystem](#) chapter in volume 3 of the *Cyclone V Device Handbook*.

Reset Interfaces

This section describes parameters in the **Resets** group on the **FPGA Interfaces** tab. You can enable most resets on an individual basis. Table 27–6 lists the available reset parameters.

Table 27–6. Reset Parameters


Parameter Name	Parameter Description	Interface Name
Enable HPS-to-FPGA cold reset output	Enable interface for HPS-to-FPGA cold reset output	h2f_cold_reset
Enable HPS warm reset handshake signals	Enable an additional pair of reset handshake signals allowing soft logic to notify the HPS when it is safe to initiate a warm reset in the FPGA fabric.	h2f_warm_reset_handshake
Enable FPGA-to-HPS debug reset request	Enable interface for FPGA-to-HPS debug reset request	f2h_debug_reset_req
Enable FPGA-to-HPS warm reset request	Enable interface for FPGA-to-HPS warm reset request	f2h_warm_reset_req
Enable FPGA-to-HPS cold reset request	Enable interface for FPGA-to-HPS cold reset request	f2h_cold_reset_req

 For more information about the reset interfaces, refer to “Functional Description of the Reset Manager” in the *Reset Manager* chapter in volume 3 of the *Cyclone V Device Handbook*.

DMA Peripheral Request

This section describes parameters in the **DMA Peripheral Request** group on the **FPGA Interfaces** tab.

You can enable each direct memory access (DMA) controller peripheral request ID individually. Each request ID enables an interface for FPGA soft logic to request one of eight logical DMA channels to the FPGA.

 Peripheral request IDs 4–7 are shared with the controller area network (CAN) controllers.

 For more information, refer to the *DMA Controller* chapter in volume 3 of the *Cyclone V Device Handbook*.

Configuring Peripheral Pin Multiplexing

This section describes parameters on the **Peripheral Pin Multiplexing** tab.

Configuring Peripherals

The **Peripheral Pin Multiplexing** tab contains a group of parameters for each available type of peripheral. You can enable one or more instances of each peripheral type by selecting an HPS I/O pin set for each instance. When enabled, some peripherals also have a mode settings specific to their functions.

Each list in the **Peripheral Pin Multiplexing** tab has a hint describing in detail the options available in the list. The hint for each pin multiplexing list shows the I/O pins used by each available pin set. The hint for each mode list shows the signals used by each available mode.

View each hint by hovering over the corresponding list.

The tooltips for the combo boxes show useful information. The pin multiplexing parameters have tables showing the pin destinations and the mode parameters show which signals are used in which mode.

You can enable the following types of peripherals. For details of peripheral-specific settings, refer to the chapter for each peripheral:

- Ethernet Media Access Controller—*Ethernet Media Access Controller* chapter in volume 3 of the *Cyclone V Device Handbook*
- NAND Flash Controller—*NAND Flash Controller* chapter in volume 3 of the *Cyclone V Device Handbook*
- Quad serial peripheral interface (SPI) Flash Controller—*Quad SPI Flash Controller* chapter in volume 3 of the *Cyclone V Device Handbook*
- Secure Digital / MultiMediaCard (SD/MMC) Controller—*SD/MMC Controller* chapter in volume 3 of the *Cyclone V Device Handbook*
- USB 2.0 On-The-Go (OTG) Controllers—*USB 2.0 OTG Controller* chapter in volume 3 of the *Cyclone V Device Handbook*
- SPI Controllers—*SPI Controller* chapter in volume 3 of the *Cyclone V Device Handbook*
- UART Controllers—*UART Controller* chapter in volume 3 of the *Cyclone V Device Handbook*
- Inter-integrated circuit (I²C) Controllers—*I2C Controller* chapter in volume 3 of the *Cyclone V Device Handbook*
- CAN Controllers—*CAN Controller* chapter in volume 3 of the *Cyclone V Device Handbook*.
- Trace port interface unit (TPIU)—*CoreSight Debug and Trace* chapter in volume 3 of the *Cyclone V Device Handbook*. Enabling the TPIU exposes trace signals to the device pins.

Connecting Unassigned Pins to GPIO

On the **Peripheral Pin Multiplexing** tab, the **Conflicts** table shows pins that are not assigned to any peripheral. By default, general-purpose I/O (GPIO) is disabled on these pins. You can enable a pin as GPIO by changing the **GPIO Enabled** field in the table. The table also shows the GPIO pin number assigned to that pin.

Resolving Pin Multiplexing Conflicts

Use the **Conflicts** table to view pins with invalid multiple assignments. The table shows one of two or more peripheral interfaces assigned to the same pin(s). You can use the peripherals' pin configuration to determine which other peripheral(s) are in conflict, and to resolve the conflict.

- For detailed information about available HPS pin configurations, refer to the *Cyclone V Device Family Pin Connection Guidelines*.

Configuring HPS Clocks

This section describes parameters on the **HPS Clocks** tab.

- For general information about clock signals, refer to the *Clock Manager* chapter in volume 3 of the *Cyclone V Device Handbook*.

User Clocks

This section describes parameters in the **User Clocks** group on the **HPS Clocks** tab.

When you enable a user clock, you must manually enter its maximum frequency for timing analysis. The TimeQuest Timing Analyzer has no other information about how software running on the HPS configures the phase-locked loop (PLL) outputs. Each possible clock, including clocks that are available from peripherals, has its own parameter for describing the clock frequency.

Table 27-7 lists the user clock parameters. The frequencies that you provide are the maximum expected frequencies. The actual clock frequencies can be modified through the register interface, for example by software running on the microprocessor unit (MPU). For further details, refer to “Selecting PLL Output Frequency and Phase” on page 27-9.

Table 27-7. User Clock Parameters

Parameter Name	Parameter Description	Clock Interface Name
Enable HPS-to-FPGA user 0 clock	Enable main PLL from HPS to FPGA	h2f_user0_clock
User 0 clock frequency	Specify the maximum expected frequency for the main PLL	
Enable HPS-to-FPGA user 1 clock	Enable peripheral PLL from HPS to FPGA	h2f_user1_clock
User 1 clock frequency	Specify the maximum expected frequency for the peripheral PLL	
Enable HPS-to-FPGA user 2 clock	Enable SDRAM PLL from HPS to FPGA	h2f_user2_clock
User 2 clock frequency	Specify the maximum expected frequency for the SDRAM PLL	

The clock frequencies you provide are reported in a Synopsys Design Constraints File (.sdc) generated by Qsys.

- For details about driving these clocks, refer to the *Clock Manager* chapter in volume 3 of the *Cyclone V Device Handbook*.

PLL Reference Clocks

This section describes parameters in the **PLL Reference Clocks** group on the **HPS Clocks** tab.

Table 27–8. PLL Reference Clock Parameters

Parameter Name	Parameter Description	Clock Interface Name
Enable FPGA-to-HPS peripheral PLL reference clock	Enable the interface for FPGA fabric to supply reference clock to HPS peripheral PLL	f2h_periph_ref_clock
Enable FPGA-to-HPS SDRAM PLL reference clock	Enable the interface for FPGA fabric to supply reference clock to HPS SDRAM PLL	f2h_sdram_ref_clock



For more information, refer to the *Clock Manager* chapter in volume 3 of the *Cyclone V Device Handbook*.

Configuring the External Memory Interface

This section describes parameters on the **SDRAM** tab.

The HPS supports one memory interface implementing double data rate 2 (DDR2), double data rate 3 (DDR3), and low-power double data rate 2 (LPDDR2) protocols. The interface can be up to 40 bits wide with optional error correction code (ECC).

Configuring the HPS SDRAM controller is similar to configuring any other Altera SDRAM controller. There are several important differences:

- The HPS parameter editor supports all SDRAM protocols with one tab. When you parameterize the SDRAM controller, you must specify the memory protocol: DDR2, DDR3, or LPDDR2.

To select the memory protocol, select DDR2, DDR3, or LPDDR2 from the **SDRAM Protocol** list in the **PHY Settings** tab in the **SDRAM** tab. After you select the protocol, settings not applicable to that protocol are disabled.



Many HPS SDRAM controller settings are the same as for Altera's dedicated DDR2, DDR3, and LPDDR2 controllers. This section only describes SDRAM parameters that are specific to the HPS component.

- Because the HPS memory controller is not configurable through the Quartus II software, the Controller and Diagnostic tabs are not present in the HPS parameter editor.
- Some settings, such as the controller settings, are not included because they can only be configured through the register interface, for example by software running on the MPU.
- Unlike the memory interface clocks in the FPGA, the memory interface clocks for the HPS are initialized by the boot-up code using values provided by the configuration process. You can accept the values provided by UniPHY, or you can use your own PLL settings, as described in *"Selecting PLL Output Frequency and Phase"*.



The HPS does not support external memory interface (EMIF) synthesis generation, compilation, or timing analysis.

The HPS memory controller cannot be bonded with a memory controller on the FPGA portion of the device.



For detailed information about SDRAM controller parameters, refer to the following chapters:

- The *Implementing and Parameterizing Memory IP* chapter in volume 2 of the *External Memory Interface Handbook*.
- The *Functional Description—Hard Memory Interface* chapter in volume 3 of the *External Memory Interface Handbook*. “EMI-Related HPS Features in SoC Devices” describes features specific to the HPS SDRAM controller.

Selecting PLL Output Frequency and Phase

You select PLL output frequency and phase with controls in the **PHY Settings** tab in the **SDRAM** tab. In the HPS, PLL frequencies and phases are set by software at system startup. A PLL might not be able to produce the exact frequency that you specify in **Memory clock frequency**. Normally, the Quartus II software sets **Achieved memory clock frequency** to the closest achievable frequency, using an algorithm that tries to balance frequency accuracy against clock jitter. This clock frequency is used for timing analysis by the TimeQuest analyzer.

It is possible to use a different software algorithm for configuring the PLLs. You can force the **Achieved memory clock frequency** box to take on the same value as **Memory clock frequency**, by turning on **Use specified frequency instead of calculated frequency** in the **PHY Settings** tab, under **Clocks**.



If you turn on **Use specified frequency instead of calculated frequency**, the Quartus II software assumes that the value in the **Achieved memory clock frequency** box is correct. If it is not, timing analysis results are incorrect.

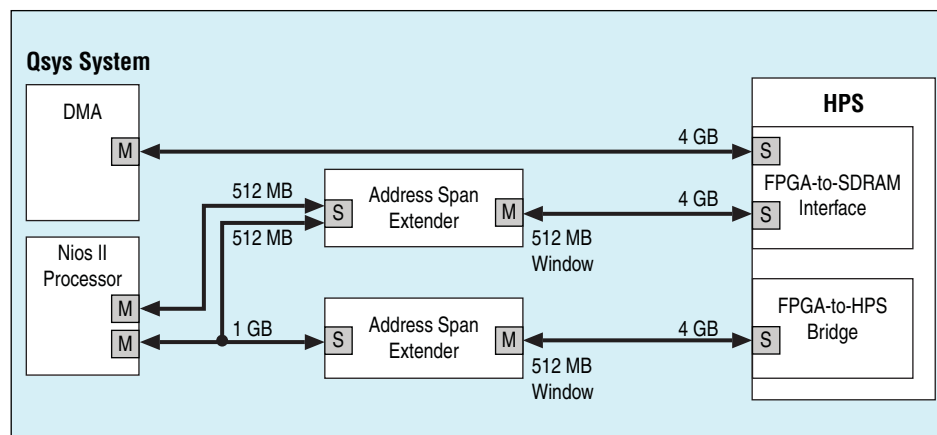
Using the Address Span Extender Component

The FPGA-to-HPS bridge and FPGA-to-HPS SDRAM memory-mapped interfaces expose their entire 4 GB address spaces to the FPGA fabric. The Address Span Extender component provides a memory-mapped window into the address space that it masters. Using the address span extender, you can expose portions of the HPS memory space without needing to expose the entire 4-GB address space.

You can use the address span extender between a soft logic master and an FPGA-to-HPS bridge or FPGA-to-HPS SDRAM interface. This component reduces the number of address bits required for a master to address a memory-mapped slave interface located in the HPS.


Figure 27-1 shows how two address span extender components might be used in a system with the HPS.

Figure 27-1. Address Span Extender



You can also use the address span extender in the HPS-to-FPGA direction, for slave interfaces in the FPGA. In this case, the HPS-to-FPGA bridge exposes a limited, variable address space in the FPGA, which can be paged in using the address span extender.


For example, suppose that the HPS-to-FPGA bridge has a 1 GB span, and the HPS needs to access three independent 1 GB memories in the FPGA portion of the device. To achieve this, the HPS programs the address span extender to access one SDRAM (1 GB) in the FPGA at a time. This technique is commonly called paging or windowing.

 For more information about the address span extender, refer to “Bridges” in the *Qsys Interconnect and System Design Components* chapter in volume 1 of the *Quartus II Handbook*.

Generating and Compiling the HPS Component


The process of generating and compiling an HPS design is very similar to the process for any other Qsys project. Perform the following steps:

1. Generate the design with Qsys. The generated files include an **.sdc** file containing clock timing constraints. If simulation is enabled, simulation files are also generated.

 For information about generating a Qsys project, refer to the *Creating a System with Qsys* chapter in volume 1 of the *Quartus II Handbook*. For a description of the simulation files generated, refer to “Simulation Flow” in the *Simulating the HPS Component* chapter in volume 3 of the *Cyclone V Device Handbook*.

2. Add **system.qip** to the Quartus II project. **system.qip** is the Quartus II IP File for the HPS component, generated by Qsys.


3. Perform Analysis and Elaboration with the Quartus II software.
4. Assign constraints to the SDRAM component. When Qsys generates the HPS component (step 1), it generates the pin assignment Tcl Script File (.tcl) to perform memory assignments. The script file name is `<qsys_system_name>_pin_assignments.tcl`, where `<qsys_system_name>` is the name of your Qsys system. Run this script to assign constraints to the SDRAM component.

 For information about running the pin assignment script, refer to “MegaWizard Plug-In Manager Flow” in the *Implementing and Parameterizing Memory IP* chapter in volume 2 of the *External Memory Interface Handbook*.

You do not need to specify pin assignments other than memory assignments. When you configure pin multiplexing as described in “*Configuring Peripheral Pin Multiplexing*” on page 27-5, you implicitly make pin assignments for all HPS peripherals. Each peripheral is routed exclusively to the pins you specify. HPS I/O signals are exported to the top level of the Qsys design, with information enabling the Quartus II software to make pin assignments automatically.

You can view and modify the assignments in the **Peripheral Pin Multiplexing** tab. You can also view the assignments in the Quartus fitter report.

5. Compile the design with the Quartus II software.
6. Optionally back-annotate the SDRAM pin assignments, to eliminate pin assignment warnings the next time you compile the design.

 For information about back-annotating pin assignments, refer to *About Back-Annotating Assignments* in Quartus II Help.

Document Revision History

Table 27-9 shows the revision history for this document.


Table 27-9. Document Revision History

Date	Version	Changes
November 2012	1.1	<ul style="list-style-type: none"> ■ Added debug interfaces ■ Added boot options ■ Corrected slave address width ■ Corrected SDRAM interface widths ■ Added TPIU peripheral ■ Added .sdc file generation ■ Added .tcl script for memory assignments
June 2012	1.0	Initial release.
May 2012	0.1	Preliminary draft.

This chapter describes the interfaces, including clocks and resets, implemented by the hard processor system (HPS) component.

The majority of the resets can be enabled on an individual basis. The exception is the `h2f_reset` interface, which is always enabled.

You must declare the clock frequency of each HPS-to-FPGA clock for timing purposes. Each possible clock, including ones that are available from peripherals, has its own parameter for describing the clock frequency. Declaring the clock frequency for HPS-to-FPGA clocks specifies how you plan to configure the PLLs and peripherals, to enable TimeQuest to accurately estimate system timing. It has no effect on PLL settings.

 For information about instantiating the HPS component, refer to the *Instantiating the HPS Component* chapter in volume 3 of the *Cyclone® V Device Handbook*. For Avalon™ protocol timing, refer to *Avalon Interface Specifications*. For Advanced Microcontroller Bus Architecture (AMBA®) Advanced eXtensible Interface (AXI™) protocol timing, refer to the *AMBA AXI Protocol Specification v1.0*, which you can download from the ARM website (infocenter.arm.com).

Memory-Mapped Interfaces

FPGA-to-HPS Bridge

Table 28–1. FPGA-to-HPS Bridges and Clocks

Interface Name	Description	Associated Clock Interface ⁽¹⁾
<code>f2h_axi_slave</code>	FPGA-to-HPS AXI slave interface	<code>f2h_axi_clock</code>

Note to Table 28–1:

(1) Refer to “Clocks” on page 28–4 for information about clock interfaces.

The FPGA-to-HPS interface is a configurable data width AXI slave allowing FPGA masters to issue transactions to the HPS. This interface allows the FPGA fabric to access the majority of the HPS slaves. This interface also provides a coherent memory interface.


The FPGA-to-HPS interface is an AXI-3 compliant interface with the following features:

- Configurable data width: 32, 64, or 128 bits

- Accelerator Coherency Port (ACP) sideband signals
- HPS-side AXI bridge to manage clock crossing, buffering, and data width conversion.


Other interface standards in the FPGA fabric, such as connecting to Avalon® Memory-Mapped (Avalon-MM) interfaces, can be supported through the use of soft logic adaptors. The Qsys system integration tool automatically generates adaptor logic to connect AXI to Avalon-MM interfaces.

This interface has an address width of 32 bits. To access existing Avalon-MM/AXI masters, you can use the Altera® Address Span Extender.

 For more information about the FPGA-to-HPS bridge, refer to the *HPS-FPGA AXI Bridges* chapter in volume 3 of the *Cyclone V Device Handbook*. For information about the address span extender, refer to “Using the Address Span Extender Component” in the *Instantiating the HPS Component* chapter in volume 3 of the *Cyclone V Device Handbook*.

ACP Sideband Signals

For communication with the ACP on the microprocessor unit (MPU) subsystem, AXI sideband signals are used to describe the inner cacheable attributes for the transaction.

 For more information about the ACP sideband signals, refer to the *Cortex-A9 Microprocessor Unit Subsystem* chapter in volume 3 of the *Cyclone V Device Handbook*.

HPS-to-FPGA and Lightweight HPS-to-FPGA Bridges

Table 28-2. HPS-to-FPGA and Lightweight HPS-to-FPGA Bridges and Clocks

Interface Name	Description	Associated Clock Interface ⁽¹⁾
h2f_axi_master	HPS-to-FPGA AXI master interface	h2f_axi_clock
h2f_lw_axi_master	HPS-to-FPGA lightweight AXI master interface	h2f_lw_axi_clock

Note to Table 28-2:

(1) Refer to “Clocks” on page 28-4 for information about clock interfaces.

The HPS-to-FPGA interface is a configurable data width AXI master (32, 64, or 128-bit) that allows HPS masters to issue transactions to the FPGA fabric.

The lightweight HPS-to-FPGA interface is a 32-bit AXI master that allows HPS masters to issue transactions to the FPGA fabric.

Both HPS-to-FPGA interfaces are AXI-3 compliant. The HPS-side AXI bridges manage clock crossing, buffering, and data width conversion where necessary.

Other interface standards in the FPGA fabric, such as connecting to Avalon-MM interfaces, can be supported through the use of soft logic adaptors. The Qsys system integration tool automatically generates adaptor logic to connect AXI to Avalon-MM interfaces.

Each AXI bridge accepts a clock input from the FPGA fabric and performs clock domain crossing internally. The exposed AXI interface operates on the same clock domain as the clock supplied by the FPGA fabric.



For more information, refer to the *HPS-FPGA AXI Bridges* chapter in volume 3 of the *Cyclone V Device Handbook*.

FPGA-to-HPS SDRAM Interface

The FPGA-to-HPS SDRAM interface is a direct connection between the FPGA fabric and the HPS SDRAM controller. This interface is highly configurable, allowing a mix between number of ports and port width. The interface supports both AXI-3 and Avalon-MM protocols.

Table 28-3. HPGA-to-HPS SDRAM Interfaces and Clocks

Interface Name	Description	Associated Clock Interface ⁽¹⁾
f2h_sdram0_data	SDRAM AXI or Avalon-MM port 0	f2h_sdram0_clock
f2h_sdram1_data	SDRAM AXI or Avalon-MM port 1	f2h_sdram1_clock
f2h_sdram2_data	SDRAM AXI or Avalon-MM port 2	f2h_sdram2_clock
f2h_sdram3_data	SDRAM AXI or Avalon-MM port 3	f2h_sdram3_clock
f2h_sdram4_data	SDRAM AXI or Avalon-MM port 4	f2h_sdram4_clock
f2h_sdram5_data	SDRAM AXI or Avalon-MM port 5	f2h_sdram5_clock

Note to Table 28-3:

(1) Refer to “Clocks” on page 28-4 for information about clock interfaces.

The FPGA-to-HPS SDRAM interface is a configurable interface to the multi-port SDRAM controller.

The total data width of all interfaces is limited to a maximum of 256 bits in the read direction and 256 bits in the write direction. The interface is implemented as four 64-bit read ports and four 64-bit write ports. As a result, the minimum data width used by the interface is 64 bits, regardless of the number or type of interfaces.

You can configure this interface the following ways:

- AXI-3 or Avalon-MM protocol
- Number of interfaces
- Data width of interfaces

The FPGA-to-HPS SDRAM interface supports six command ports, allowing up to six Avalon-MM interfaces or three bidirectional AXI interfaces.

Each command port is available either to implement a read or write command port for AXI, or to form part of an Avalon-MM interface.

You can use a mix of Avalon-MM and AXI interfaces, limited by the number of command/data ports available. Some AXI features are not present in Avalon-MM interfaces.

This interface has an address width of 32 bits. To access existing Avalon-MM/AXI masters, you can use the Altera Address Span Extender.



For more information about available combinations of interfaces and ports, refer to the *SDRAM Controller Subsystem* chapter in volume 3 of the *Cyclone V Device Handbook*. For information about the address span extender, refer to “Using the Address Span Extender Component” in the *Instantiating the HPS Component* chapter in volume 3 of the *Cyclone V Device Handbook*.

Clocks

The HPS-to-FPGA clock interface supplies physical clocks and resets to the FPGA. These clocks and resets are generated in the HPS.

Alternative Clock Inputs to HPS PLLs

This section lists alternative clock inputs to HPS PLLs.

- `f2h_periph_ref_clock`—FPGA-to-HPS peripheral PLL reference clock. You can connect this clock input to a clock in your design that is driven by the clock network on the FPGA side.
- `f2h_sdram_ref_clock`—FPGA-to-HPS SDRAM PLL reference clock. You can connect this clock to a clock in your design that is driven by the clock network on the FPGA side.

User Clocks

A user clock is a PLL output that is connected to the FPGA fabric rather than the HPS. You can connect a user clock to logic that you instantiate in the FPGA fabric.

- `h2f_user0_clock`—HPS-to-FPGA user clock, driven from main PLL
- `h2f_user1_clock`—HPS-to-FPGA user clock, driven from peripheral PLL
- `h2f_user2_clock`—HPS-to-FPGA user clock, driven from SDRAM PLL

AXI Bridge FPGA Interface Clocks

The AXI interface has an asynchronous clock crossing in the FPGA-to-HPS bridge. The FPGA-to-HPS and HPS-to-FPGA interfaces are synchronized to clocks generated in the FPGA fabric. These interfaces can be asynchronous to one another. The SDRAM controller’s multiport front end (MPFE) transfers the data between the FPGA and HPS clock domains.

- `f2h_axi_clock`—AXI slave clock for FPGA-to-HPS bridge, generated in FPGA fabric
- `h2f_axi_clock`—AXI master clock for HPS-to-FPGA bridge, generated in FPGA fabric
- `h2f_lw_axi_clock`—AXI master clock for lightweight HPS-to-FPGA bridge, generated in FPGA fabric

SDRAM Clocks

You can configure the HPS component with up to six FPGA-to-HPS SDRAM clocks.

Each command channel to the SDRAM controller has an individual clock source from the FPGA fabric. The interface clock is always supplied by the FPGA fabric, with clock crossing occurring on the HPS side of the boundary.

The FPGA-to-HPS SDRAM clocks are driven by soft logic in the FPGA fabric.

- f2h_sdram0_clock—SDRAM clock for port 0
- f2h_sdram1_clock—SDRAM clock for port 1
- f2h_sdram2_clock—SDRAM clock for port 2
- f2h_sdram3_clock—SDRAM clock for port 3
- f2h_sdram4_clock—SDRAM clock for port 4
- f2h_sdram5_clock—SDRAM clock for port 5

Resets

This section describes the reset interfaces to the HPS component.



For details about the HPS reset sequences, refer to “Functional Description of the Reset Manager” in the *Reset Manager* chapter in volume 3 of the *Cyclone V Device Handbook*.

HPS-to-FPGA Reset Interfaces

The following interfaces allow the HPS to reset soft logic in the FPGA fabric:

- h2f_reset—HPS-to-FPGA cold and warm reset
- h2f_cold_reset—HPS-to-FPGA cold reset
- h2f_warm_reset_handshake—Warm reset request and acknowledge interface between HPS and FPGA

HPS External Reset Sources

The following interfaces allow soft logic in the FPGA fabric to reset the HPS:

- f2h_cold_reset_req—FPGA-to-HPS cold reset request
- f2h_warm_reset_req—FPGA-to-HPS warm reset request
- f2h_dbg_reset_req—FPGA-to-HPS debug reset request

Debug and Trace Interfaces

Trace Port Interface Unit

The TPIU is a bridge between on-chip trace sources and a trace port.

- h2f_tpiu
- h2f_tpiu_clock_in

FPGA System Trace Macrocell Events Interface

The system trace macrocell (STM) hardware events allow logic in the FPGA to insert messages into the trace stream.

- f2h_stm_hw_events

FPGA Cross Trigger Interface

The cross trigger interface (CTI) allows trigger sources and sinks to interface with the embedded cross trigger (ECT).

- h2f_cti
- h2f_cti_clock

Debug APB Interface

The debug Advanced Peripheral Bus (APB™) interface allows debug components in the FPGA fabric to debug components on the CoreSight™ debug APB.

- h2f_debug_apb
- h2f_debug_apb_sideband
- h2f_debug_apb_reset
- h2f_debug_apb_clock

Peripheral Signal Interfaces

DMA Controller Peripheral Request Interfaces

The DMA controller interface allows soft IP in the FPGA fabric to communicate with the DMA controller in the HPS. You can configure up to eight separate interface channels.

- f2h_dma_req0—FPGA DMA controller peripheral request interface 0
- f2h_dma_req1—FPGA DMA controller peripheral request interface 1
- f2h_dma_req2—FPGA DMA controller peripheral request interface 2
- f2h_dma_req3—FPGA DMA controller peripheral request interface 3
- f2h_dma_req4—FPGA DMA controller peripheral request interface 4
- f2h_dma_req5—FPGA DMA controller peripheral request interface 5
- f2h_dma_req6—FPGA DMA controller peripheral request interface 6
- f2h_dma_req7—FPGA DMA controller peripheral request interface 7



For more information, refer to the *DMA Controller* chapter in volume 3 of the *Cyclone V Device Handbook*.

Other Interfaces

MPU Standby and Event Interfaces

MPU standby and event signals are notification signals to the FPGA fabric that the MPU is in standby. Event signals are used to wake up the Cortex-A9 processors from a wait for event (WFE) state. The standby and event signals are included in the following interfaces:

- `h2f_mpu_events`—MPU standby and event interface, including the following signals:
 - `h2f_mpu_eventi`—Sends an event from logic in the FPGA fabric to the MPU. This FPGA-to-HPS signal is used to wake up a processor that is in a Wait For Event state. Asserting this signal has the same effect as executing the SEV instruction in the Cortex-A9. This signal must be de-asserted until the FPGA fabric is powered-up and configured.
 - `h2f_mpu_evento`—Sends an event from the MPU to logic in the FPGA fabric. This HPS-to-FPGA signal is asserted when an SEV instruction is executed by one of the Cortex-A9 processors.
 - `h2f_mpu_standbywfe[1:0]`—Indicates whether each Cortex-A9 processor is in the WFE state
 - `h2f_mpu_standbywfi[1:0]`—Indicates whether each Cortex-A9 processor is in the wait for interrupt (WFI) state
- `h2f_mpu_gp`—General purpose interface

The MPU provides signals to indicate when it is in a standby state. These signals are available to custom hardware designs in the FPGA fabric.



For more information, refer to the *Cortex-A9 Microprocessor Unit Subsystem* chapter in volume 3 of the *Cyclone V Device Handbook*.

FPGA-to-HPS Interrupts

You can configure the HPS component to provide 64 general-purpose FPGA-to-HPS interrupts, allowing soft IP in the FPGA fabric to trigger interrupts to the MPU's generic interrupt controller (GIC). The interrupts are implemented through the following 32-bit interfaces:

- `f2h_irq0`—FPGA-to-HPS interrupts 0 through 31
- `f2h_irq1`—FPGA-to-HPS interrupts 32 through 63

The FPGA-to-HPS interrupts are asynchronous on the FPGA interface. Inside the HPS, the interrupts are synchronized to the MPU's internal peripheral clock (`periphclk`).

General-Purpose Interfaces

You can use the FPGA manager to supply the `h2f_mpu_gp` interface, which includes the following general-purpose signals:

- 32 FPGA-to-HPS signals
- 32 HPS-to-FPGA signals



For more information, refer to the *FPGA Manager* chapter in volume 3 of the *Cyclone V Device Handbook*.

Document Revision History

Table 28-4 shows the revision history for this document.

Table 28-4. Document Revision History

Date	Version	Changes
November 2012	1.1	<ul style="list-style-type: none"> ■ Added debug interfaces. ■ Updated HPS-to-FPGA reset interface names. ■ Updated HPS external reset source interface names. ■ Removed DMA peripheral interface clocks. ■ Referred to Altera Address Span Extender.
June 2012	1.0	Initial release.
May 2012	0.1	Preliminary draft.

HPS Simulation Support

This section describes the simulation support for the hard processor system (HPS) component. The HPS simulation models support interfaces between the HPS and FPGA fabric, including:

- Bus functional models (BFMs) for most interfaces between HPS and FPGA fabric
- A simulation model for the HPS SDRAM memory

The HPS simulation support does not include modules implemented in the HPS, such as the ARM® Cortex™-A9 MPCore processor.

You specify simulation support files when you instantiate the HPS component in the Qsys system integration tool. When you enable a particular HPS-FPGA interface, Qsys provides the corresponding model during the generation process. Refer to “Simulation Flows” on page 29–10 for a description of the simulation flows.



For general information about instantiating the component, refer to the *Instantiating the HPS Component* chapter in volume 3 of the *Cyclone® V Device Handbook*.

The HPS simulation support enables you to develop and verify your own FPGA soft logic or intellectual property (IP) that interfaces to the HPS component.

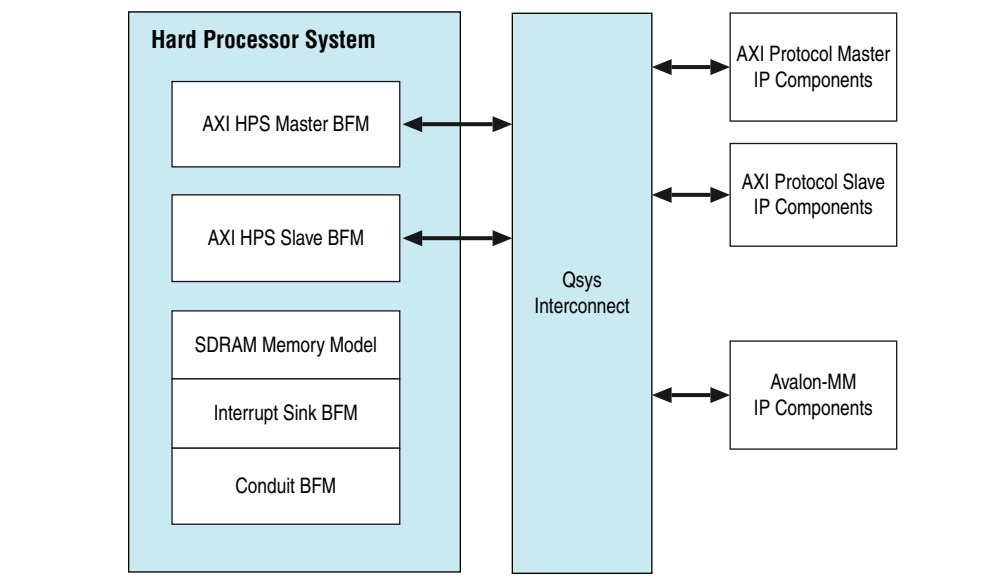
The simulation model supports the following interfaces:

- Clock and reset interfaces
- FPGA-to-HPS Advanced Microcontroller Bus Architecture (AMBA®) Advanced eXtensible Interface (AXI™) slave interface
- HPS-to-FPGA AXI master interface
- Lightweight HPS-to-FPGA AXI master interface
- FPGA-to-HPS SDRAM interface
- Microprocessor unit (MPU) general-purpose I/O interface
- MPU standby and event interface
- Interrupts interface
- Direct memory access (DMA) controller peripheral request interface
- Debug Advanced Peripheral Bus (APB™) interface
- System Trace Macrocell (STM) hardware event

- FPGA cross trigger interface
- FPGA trace port interface

Figure 29-1 on page 29-2 shows the HPS with its BFM.

Figure 29-1. HPS BFM Block Diagram



The HPS BFM uses standard function calls from the Altera® BFM application programming interface (API), as detailed in the remainder of this section.

For information about the BFM API, refer to the *Avalon Verification IP Suite User Guide* and the *Mentor Verification IP Altera Edition User Guide*.

HPS simulation supports only Verilog HDL or SystemVerilog simulation environments.

Clock and Reset Interfaces

For general information about clock and reset interfaces, refer to “Memory-Mapped Interfaces” in the *HPS Component Interfaces* chapter in volume 3 of the *Cyclone V Device Handbook*.

Clock Interface

Qsys generates the clock source BFM for each clock output interface from the HPS component. For HPS-to-FPGA user clocks, specify the BFM clock rate in the **User clock frequency** field in the **HPS Clocks** page when instantiating the HPS component in Qsys.

The HPS-to-FPGA trace port interface unit generates a clock output to the FPGA, named `h2f_tpiu_clock`. In simulation, the clock source BFM also represents this clock output’s behavior.

Table 29–1 lists all HPS clock output interfaces with the BFM instance name.

Table 29–1. HPS Clock Output Interface Simulation Model

Interface Name	BFM Instance Name
h2f_user0_clock	h2f_user0_clock
h2f_user1_clock	h2f_user1_clock
h2f_user2_clock	h2f_user2_clock
h2f_tpiu_clock	h2f_tpiu_clock

The Altera clock source BFM application programming interface (API) applies to all the BFM instance names listed in Table 29–1. Your Verilog interfaces use the same API, passing in different instance names.

Qsys does not generate BFM instance names for FPGA-to-HPS clock input interfaces.

Reset Interface

The HPS reset request and handshake interfaces are connected to Altera conduit BFM instance names for simulation. Table 29–2 lists the name of each interface. You can monitor the reset request interface state changes or set the interface by using the API listed in Table 29–2.

Table 29–2. HPS Reset Input Interface Simulation Model

Interface Name	BFM Instance Name	API Function Names
f2h_cold_reset_req	f2h_cold_reset_req	get_f2h_cold_rst_req_n()
f2h_debug_reset_req	f2h_debug_reset_req	get_f2h_dbg_rst_req_n()
f2h_warm_reset_req	f2h_warm_reset_req	get_f2h_warm_rst_req_n()
h2f_warm_reset_handshake	h2f_warm_reset_handshake	set_h2f_pending_rst_req_n() get_f2h_pending_rst_ack_n()

Table 29–3 lists all HPS reset output interfaces with the BFM instance name. The Altera reset source BFM application programming interface applies to all the BFM instance names listed in Table 29–3.

Table 29–3. HPS Reset Output Interface Simulation Model

Interface Name	BFM Instance Name
h2f_reset	h2f_reset
h2f_cold_reset	h2f_cold_reset
h2f_debug_apb_reset	h2f_debug_apb_reset

The HPS reset output interface is connected to a reset source BFM. Qsys configures the BFM as shown in [Table 29-4](#).

Table 29-4. Configuration of Reset Source BFM for HPS Reset Output Interface

Parameter	BFM Value ⁽¹⁾	Meaning
Assert reset high	Off	This parameter is off, specifying an active-low reset signal from the BFM.
Cycles of initial reset	0	This parameter is 0, specifying that the BFM does not assert the reset signal automatically.
Note to Table 29-4: (1) The parameter value of the instantiated BFM as configured for HPS simulation		

FPGA-to-HPS AXI Slave Interface

The FPGA-to-HPS AXI slave interface, `f2h_axi_slave`, is connected to a Mentor Graphics AXI slave BFM for simulation. Qsys configures the BFM as shown in [Table 29-5](#). The BFM clock input is connected to `f2h_axi_clock` clock.

Table 29-5. Configuration of FPGA-to-HPS AXI Slave BFM

Parameter	Value
AXI Address Width	32
AXI Read Data Width	32, 64, 128
AXI Write Data Width	32, 64, 128
AXI ID Width	8

You control and monitor the AXI slave BFM by using the BFM API.



For more information, refer to the [Mentor Verification IP Altera Edition User Guide](#). For general information about FPGA-to-HPS AXI slave interfaces, refer to “Memory-Mapped Interfaces” in the [HPS Component Interfaces](#) chapter in volume 3 of the *Cyclone V Device Handbook*.

HPS-to-FPGA AXI Master Interface

The HPS-to-FPGA AXI master interface, `h2f_axi_master`, is connected to a Mentor Graphics AXI master BFM for simulation. Qsys configures the BFM as shown in [Table 29-6](#). The BFM clock input is connected to `h2f_axi_clock` clock.

Table 29-6. Configuration of HPS-to-FPGA AXI Master BFM

Parameter	Value
AXI Address Width	30
AXI Read and Write Data Width	32, 64, 128
AXI ID Width	12

You control and monitor the AXI master BFM by using the BFM API.

- For more information, refer to the *Mentor Verification IP Altera Edition User Guide*. For general information about HPS-to-FPGA AXI master interfaces, refer to “Memory-Mapped Interfaces” in the *HPS Component Interfaces* chapter in volume 3 of the *Cyclone V Device Handbook*.

Lightweight HPS-to-FPGA AXI Master Interface

The lightweight HPS-to-FPGA AXI master interface, `h2f_lw_axi_master`, is connected to a Mentor Graphics AXI master BFM for simulation. Qsys configures the BFM as shown in [Table 29-7](#). The BFM clock input is connected to `h2f_lw_axi_clock` clock.

Table 29-7. Configuration of Lightweight HPS-to-FPGA AXI Master BFM

Parameter	Value
AXI Address Width	21
AXI Read and Write Data Width	32
AXI ID Width	12

You control and monitor the AXI master BFM by using the BFM API.

- For more information, refer to the *Mentor Verification IP Altera Edition User Guide*. For general information about lightweight HPS-to-FPGA AXI master interfaces, refer to “Memory-Mapped Interfaces” in the *HPS Component Interfaces* chapter in volume 3 of the *Cyclone V Device Handbook*.

FPGA-to-HPS SDRAM Interface

The HPS component contains a memory interface simulation model to which all of the FPGA-to-HPS SDRAM interfaces are connected. The model is based on the HPS implementation and provides cycle-level accuracy, reflecting the true bandwidth and latency of the interface. However, the model does not have the detailed configuration provided by the HPS software, and hence does not reflect any inter-port scheduling that might occur under contention on the real hardware when different priorities or weights are used.

- For more information, refer to “EMI-Related HPS Features in SoC Devices” in the *Functional Description—Hard Memory Interface* chapter in volume 3 of the *External Memory Interface Handbook*.

HPS-to-FPGA MPU General-Purpose I/O Interface

The HPS-to-FPGA MPU general-purpose I/O interface is connected to an Altera conduit BFM for simulation. Table 29-8 lists the name of each interface, along with API function names for each type of simulation. You can monitor the interface state changes or set the interface by using the API listed in Table 29-8.

Table 29-8. HPS-to-FPGA MPU General-Purpose I/O Interface Simulation Model

Interface Name	BFM Instance Name	RTL Simulation API Function Names	Post-Fit Simulation API Function Names
h2f_mpu_gp	h2f_mpu_gp	set_h2f_mpu_gp_out() get_h2f_mpu_gp_in()	set_gp_out() get_gp_in()

HPS-to-FPGA MPU Event Interface

The HPS-to-FPGA MPU event interface is connected to an Altera conduit BFM for simulation. Table 29-9 lists the name of each interface, along with API function names for each type of simulation. You can monitor the interface state changes or set the interface by using the API listed in Table 29-9.

Table 29-9. HPS-to-FPGA MPU Event Interface Simulation Model

Interface Name	BFM Instance Name	RTL Simulation API Function Names ⁽¹⁾	Post-Fit Simulation API Function Names
h2f_mpu_events	h2f_mpu_events	get_h2f_mpu_eventi() set_h2f_mpu_evento() set_h2f_mpu_standbywfe() set_h2f_mpu_standbywfi()	get_eventi() set_evento() set_standbywfe() set_standbywfi()

Note to Table 29-9:

(1) The usage of conduit get_*() and set_*() API functions is the same as with the general Avalon conduit BFM.

FPGA-to-HPS Interrupts Interface

The FPGA-to-HPS interrupts interface is connected to an Altera Avalon interrupt sink BFM for simulation. Table 29-10 lists the name of each interface.

Table 29-10. FPGA-to-HPS Interrupts Interface Simulation Model

Interface Name	BFM Instance Name
f2h_irq0	f2h_irq0
f2h_irq1	f2h_irq1

The Altera Avalon interrupt sink BFM API applies to all the BFMs listed in Table 29-3.

HPS-to-FPGA Debug APB Interface

The HPS-to-FPGA debug APB interface is connected to an Altera conduit BFM for simulation. Table 29-11 lists the name of each interface, along with API function names for each type of simulation. You can monitor the interface state changes or set the interface by using the API functions listed in Table 29-11.

Table 29-11. HPS-to-FPGA Debug APB Interface Simulation Model

Interface Name	BFM Name	RTL Simulation API Function Names	Post-Fit Simulation API Function Names
h2f_debug_apb	h2f_debug_apb	set_h2f_dbg_apb_PADDR() set_h2f_dbg_apb_PADDR_31() set_h2f_dbg_apb_PENABLE() get_h2f_dbg_apb_PRDATA() get_h2f_dbg_apb_PREADY() set_h2f_dbg_apb_PSEL() get_h2f_dbg_apb_PSLVERR() set_h2f_dbg_apb_PWDATA() set_h2f_dbg_apb_PWRITE()	set_PADDR() set_PADDR_31() set_PENABLE() get_PRDATA() get_PREADY() set_PSEL() get_PSLVERR() set_PWDATA() set_PWRITE()
h2f_debug_apb_side band	h2f_debug_apb_side band	get_h2f_dbg_apb_PCLKEN() get_h2f_dbg_apb_DBG_APB_DISABLE()	get_PCLKEN() get_DBG_APB_DISABLE()

FPGA-to-HPS System Trace Macrocell (STM) Hardware Event Interface

The FPGA-to-HPS STM hardware event interface is connected to an Altera conduit BFM for simulation. Table 29-12 lists the name of each interface, along with API function name for each type of simulation. You can monitor the interface state changes or set the interface by using the API functions listed in Table 29-12.

Table 29-12. FPGA-to-HPS STM Hardware Event Interface Simulation Model

Interface Name	BFM Name	RTL Simulation API Function Name	Post-Fit Simulation API Function Name
f2h_stm_hw_events	f2h_stm_hw_events	get_f2h_stm_hwevents()	get_stm_events()

HPS-to-FPGA Cross-Trigger Interface

The HPS-to-FPGA cross-trigger interface is connected to an Altera conduit BFM for simulation. Table 29-13 lists the name of each interface, along with API function names for each type of simulation. You can monitor the interface state changes or set the interface by using the API functions listed in Table 29-13.

Table 29-13. HPS-to-FPGA Cross-Trigger Interface Simulation Model

Interface Name	BFM Name	RTL Simulation API Function Names	Post-Fit Simulation API Function Names
h2f_cti	h2f_cti	get_h2f_cti_trig_in() set_h2f_cti_trig_in_ack() set_h2f_cti_trig_out() get_h2f_cti_trig_out_ack() set_h2f_cti_asicctl() get_h2f_cti_fpga_clk_en()	get_trig_in() set_trig_inack() set_trig_out() get_trig_outack() set_asicctl() get_clk_en()

HPS-to-FPGA Trace Port Interface

The HPS-to-FPGA trace port interface is connected to an Altera conduit BFM for simulation. Table 29-14 lists the name of each interface, along with API function names for each type of simulation. You can monitor the interface state changes or set the interface by using the API functions listed in Table 29-14.

Table 29-14. HPS-to-FPGA Trace Port Interface Simulation Model

Interface Name	BFM Name	RTL Simulation API Function Names	Post-Fit Simulation API Function Names
h2f_tpiu	h2f_tpiu	get_h2f_tpiu_clk_ctl() set_h2f_tpiu_data()	get_traceclk_ctl() set_trace_data()

FPGA-to-HPS DMA Handshake Interface

The FPGA-to-HPS DMA handshake interface is connected to an Altera conduit BFM for simulation. Table 29-15 lists the name for each interface, along with API function names for each type of simulation. You can monitor the interface state changes or set the interface by using the API listed in Table 29-15.

Table 29-15. FPGA-to-HPS DMA Handshake Interface Simulation Model

Interface Name	BFM Instance Name	RTL Simulation API Function Names ⁽¹⁾	Post-Fit Simulation API Function Names
f2h_dma_req0	f2h_dma_req0	get_f2h_dma_req0_req() get_f2h_dma_req0_single() set_f2h_dma_req0_ack()	get_channel0_req() get_channel0_single() set_channel0_xx_ack()
f2h_dma_req1	f2h_dma_req1	get_f2h_dma_req1_req() get_f2h_dma_req1_single() set_f2h_dma_req1_ack()	get_channel1_req() get_channel1_single() set_channel1_xx_ack()
f2h_dma_req2	f2h_dma_req2	get_f2h_dma_req2_req() get_f2h_dma_req2_single() set_f2h_dma_req2_ack()	get_channel2_req() get_channel2_single() set_channel2_xx_ack()
f2h_dma_req3	f2h_dma_req3	get_f2h_dma_req3_req() get_f2h_dma_req3_single() set_f2h_dma_req3_ack()	get_channel3_req() get_channel3_single() set_channel3_xx_ack()
f2h_dma_req4	f2h_dma_req4	get_f2h_dma_req4_req() get_f2h_dma_req4_single() set_f2h_dma_req4_ack()	get_channel4_req() get_channel4_single() set_channel4_xx_ack()
f2h_dma_req5	f2h_dma_req5	get_f2h_dma_req5_req() get_f2h_dma_req5_single() set_f2h_dma_req5_ack()	get_channel5_req() get_channel5_single() set_channel5_xx_ack()
f2h_dma_req6	f2h_dma_req6	get_f2h_dma_req6_req() get_f2h_dma_req6_single() set_f2h_dma_req6_ack()	get_channel6_req() get_channel6_single() set_channel6_xx_ack()
f2h_dma_req7	f2h_dma_req7	get_f2h_dma_req7_req() get_f2h_dma_req7_single() set_f2h_dma_req7_ack()	get_channel7_req() get_channel7_single() set_channel7_xx_ack()
Note to Table 29-15: (1) The usage of conduit get_*() and set_*() API functions is the same as with the general Avalon conduit BFM.			

Simulation Flows

This section describes the simulation flows for an HPS-based design.

Altera provides both functional register transfer level (RTL) simulation and post-fitter gate-level simulation flows. The simulation flows involve the following major steps:

1. Instantiate the HPS component—Refer to [“Specifying HPS Simulation Model in Qsys”](#) on page 29–10.
2. Generate the system in Qsys, including the simulation model—Refer to [“Generating HPS Simulation Model in Qsys”](#) on page 29–13.
3. Run the simulation—Refer to one of the following sections:
 - [“Running HPS RTL Simulation”](#) on page 29–13
 - [“Running HPS Post-Fit Simulation”](#) on page 29–14



For general information about simulation, refer to the [Simulating Altera Designs](#) chapter in volume 3 of the *Quartus II Handbook*.

Specifying HPS Simulation Model in Qsys

The following steps outline how to set up the HPS component for simulation.

1. Add the HPS component from the Qsys Component Library.
2. Configure the component based on your application needs by selecting or deselecting the HPS-FPGA interfaces.
3. Connect the appropriate HPS interfaces to other components in the system. For example, connect the FPGA-to-HPS AXI slave interface to an AXI master interface in another component in the system.

When you create your component, make sure the conduit interfaces have the correct role names, directions, and widths. [Table 29–16](#) lists the role names, directions, and widths for all the HPS conduit interfaces.



For general information about adding the HPS component to your design, refer to the [Instantiating the HPS Component](#) chapter in volume 3 of the *Cyclone V Device Handbook*.

Table 29–16. HPS Conduit Interfaces (Part 1 of 3)

Role Name	Direction	Width
h2f_warm_reset_handshake		
h2f_pending_rst_req_n	Output	1
f2h_pending_rst_ack_n	Input	1
h2f_mpu_gp		
gp_in	Input	32
gp_out	Output	32

Table 29-16. HPS Conduit Interfaces (Part 2 of 3)

Role Name	Direction	Width
h2f_mpu_events		
eventi	Input	1
evento	Output	1
standbywfe	Output	2
standbywfi	Output	2
f2h_dma_req0		
req0_req	Input	1
req0_single	Input	1
req0_ack	Output	1
f2h_dma_req1		
req1_req	Input	1
req1_single	Input	1
req1_ack	Output	1
f2h_dma_req2		
req2_req	Input	1
req2_single	Input	1
req2_ack	Output	1
f2h_dma_req3		
req3_req	Input	1
req3_single	Input	1
req3_ack	Output	1
f2h_dma_req4		
req4_req	Input	1
req4_single	Input	1
req4_ack	Output	1
f2h_dma_req5		
req5_req	Input	1
req5_single	Input	1
req5_ack	Output	1
f2h_dma_req6		
req6_req	Input	1
req6_single	Input	1
req6_ack	Output	1
f2h_dma_req7		
req7_req	Input	1
req7_single	Input	1
req7_ack	Output	1

Table 29-16. HPS Conduit Interfaces (Part 3 of 3)

Role Name	Direction	Width
h2f_debug_apb		
paddr	Input	18
paddr_31	Input	1
penable	Input	1
prdata	Output	32
pready	Output	1
psel	Input	1
pslverr	Output	1
pwdata	Input	32
pwrite	Input	1
h2f_debug_apb_sideband		
pclken	Output	1
dbg_apb_disable	Output	1
f2h_stm_hw_events		
stm_hwevents	Output	28
h2f_cti		
trig_in	Output	8
trig_in_ack	Input	8
trig_out	Input	8
trig_out_ack	Output	8
asicctl	Input	8
fpga_clk_en	Output	1
h2f_tpiu		
clk_ctl	Output	1
data	Input	32

Generating HPS Simulation Model in Qsys

The following steps outline how to generate the simulation model.

1. Go to the **Generation** page in Qsys.
2. For RTL simulation, perform the following steps:
 - a. Set **Create simulation model to Verilog**.
 - b. Click **Generate**.



HPS simulation does not support the VHDL simulation environment.

For post-fit simulation, perform the following steps:

- a. Turn on the **Create HDL design files for synthesis** option.
- b. Turn on the **Create block symbol file (.bsf)** option.
- c. Click **Generate**.



For general information about generating the HPS component, refer to the *Instantiating the HPS Component* chapter in volume 3 of the *Cyclone V Device Handbook*. For more information about Qsys simulation, refer to “Simulating a Qsys System” in the *Creating a System with Qsys* chapter in volume 1 of the *Quartus II Handbook*.

Running HPS RTL Simulation

Qsys generates scripts for various simulators that you use to complete the simulation process. Table 29-17 lists simulation tools, script names and the script directories for various vendors.

Table 29-17. Qsys-Generated Scripts for Various Simulators

Simulator	Script Name	Directory
Mentor Graphics Modelsim® Altera Edition	msim_setup.tcl	<project directory>/<Qsys design name>/simulation/mentor
Cadence NC-Sim	ncsim_setup.sh	<project directory>/<Qsys design name>/simulation/cadence
Synopsys VCS	vcs_setup.sh	<project directory>/<Qsys design name>/simulation/synopsys/vcs
Synopsys VCS-MX	vcsmx_setup.sh	<project directory>/<Qsys design name>/simulation/synopsys/vcsmx



For detailed simulation steps, refer to the *Mentor Verification IP Altera Edition User Guide*, and to the *Qsys Tutorial* chapter of the *Avalon Verification IP Suite User Guide*.

Running HPS Post-Fit Simulation

The section describes how you run HPS post-fit simulation. After successful Qsys generation, perform the following steps:

1. Add the Qsys-generated synthesis file set to your Quartus II project by performing the following steps:
 - a. In the Quartus II software, click **Settings** in the Assignments menu.
 - b. In the **Settings - <your Qsys system name>** dialog box, on the **Files** tab, browse to <your project directory>/<your Qsys system name>/**synthesis/** and select <your Qsys system name>.**qip**.
 - c. Click **OK**.
 2. You can instantiate the Qsys system that contains HPS component as your Quartus II project top-level entity, if necessary.
 3. Compile the design by clicking **Start Compilation** in the Processing menu.
 4. Change the EDA Netlist Writer settings, if necessary, by performing the following steps:
 - a. Click **Settings** in the Assignment menu.
 - b. On the **Simulation** tab, under the **EDA Tool Settings** tab, you can specify the following EDA Netlist Writer settings:
 - **Tool name**—The name of the simulation tool
 - **Format for output netlist**
 - **Output directory**
 - c. Click **OK**.
- ❓ For more information about EDA Netlist Writer settings, refer to *Simulation Page (Settings Dialog Box)* in Quartus II Help.
5. To create the post-fitter simulation model with Quartus II EDA Netlist Writer, in the Start menu, point to **Processing** and click **Start EDA Netlist Writer**.
 6. Compile the necessary simulation files in your simulation tool. [Table 29-18](#) lists the required libraries and files.
 7. Start simulation.

Table 29-18. Post-Fit Simulation Files

Library	Directory ⁽¹⁾	File
Altera Verification IP Library	<Avalon Verification IP>/lib/	verbosity_pkg.sv avalon_mm_pkg.sv avalon_utilities_pkg.sv
Avalon Clock Source BFM	<Avalon Verification IP>/altera_avalon_clock_source/	altera_avalon_clock_source.sv
Avalon Reset Source BFM	<Avalon Verification IP>/altera_avalon_reset_source/	altera_avalon_reset_source.sv
Avalon MM Slave BFM	<Avalon Verification IP>/altera_avalon_mm_slave_bfm/	altera_avalon_mm_slave_bfm.sv
Avalon Interrupt Sink BFM	<Avalon Verification IP>/altera_avalon_interrupt_sink/	altera_avalon_interrupt_sink.sv
Mentor AXI Verification IP Library	<AXI Verification IP>/common/	questa_mvc_svapi.svh
Mentor AXI3 BFM	<AXI Verification IP>/axi3/bfm/	mgc_common_axi.sv mgc_axi_master.sv mgc_axi_slave.sv
HPS Post-Fit Simulation Library	<HPS Post-fit Sim>/	All the files in the directory
Device Simulation Library ⁽²⁾	<Device Sim Lib>/	altera_primitives.v 220model.v sgate.v altera_mf.v altera_Insim.sv cyclonev_atoms.v arriav_atoms.v mentor/cyclonev_atoms_ncrypt.v mentor/arriav_atoms_ncrypt.v
EDA Netlist Writer Generated Post-Fit Simulation Model	<User project directory>/	*.vo *.vho ⁽³⁾
User testbench files	<User project directory>/	*.v *.sv *.vhd ⁽³⁾

Notes to Table 29-18:

- (1) <ACDS install> = Altera Complete Design Suite installation path
 <Avalon Verification IP> = <ACDS install>/ip/altera/sopc_builder_ip/verification
 <AXI Verification IP> = <ACDS install>/ip/altera/mentor_vip_ae
 <HPS Post-fit Sim> = <ACDS install>/ip/altera/hps/postfitter_simulation
 <Device Sim Lib> = <ACDS install>/quartus/eda/sim_lib
- (2) The device simulation library is not needed with Modelsim-Altera.
- (3) Mixed-language simulator is needed for Verilog HDL and VHDL mixed design

For post-fit simulation, you must call the BFM API in your test program with a specific hierarchy. The hierarchy format is:

```
<DUT>.\<HPS>|fpga_interfaces|<interface><space>.<BFM>.<API function>
```

Where:

- **<DUT>** is the instance name of the design under test that you instantiated in your test bench that consists of the HPS component.
- **<HPS>** is the HPS component instance name that you use in your Qsys system.
- **<interface>** is the instance name for a specific FPGA-to-HPS or HPS-to-FPGA interface. This name can be found in the **fpga_interfaces.sv** file located in *<project directory>/<Qsys design name>/synthesis/submodules*.
- **<space>**—You must insert one space character after the interface instance name.
- **<BFM>** is the BFM instance name. In *<ACDS install>/ip/altera/hps/postfitter_simulation*, identify the SystemVerilog file corresponding to the interface type that you are using. The SystemVerilog file contains the BFM instance name.

For example, a path for the Lightweight HPS-to-FPGA master interface hierarchy could be formed as follows:

```
top.dut.\my_hps_component|fpga_interface|hps2fpga_light_weight .h2f_lw_axi_master
```

Notice the space after “hps2fpga_light_weight”. Omitting this space would cause simulation failure because the instance name “hps2fpga_light_weight ”, including the space, is the name used in the post-fit simulation model generated by the Quartus® II software.

Document Revision History

Table 29–19 lists the revision history for this document.

Table 29–19. Document Revision History

Date	Version	Changes
November 2012	1.1	<ul style="list-style-type: none"> ■ Added debug APB, STM hardware event, FPGA cross trigger, FPGA trace port interfaces. ■ Added support for post-fit simulation. ■ Updated some API function names. ■ Removed DMA peripheral clock.
June 2012	1.0	Initial release.
May 2012	0.1	Preliminary draft.

This section includes the following appendices:

- [Appendix A, Booting and Configuration](#)



For information about the revision history for chapters in this section, refer to “Document Revision History” in each individual chapter.

This appendix describes the booting of the hard processor system (HPS) and the configuration of the FPGA portion of the Altera system-on-a-chip (SoC) FPGA device.

The HPS boot starts when a processor is released from reset (for example, on power up) and executes code in the internal boot ROM at the reset exception address. The boot process ends when the code in the boot ROM jumps to the next stage of the boot software. This next stage of boot software is referred to as the preloader. The preloader can be customized and is typically stored external to the HPS in a nonvolatile flash-based memory.

The processor can boot from the following sources:

- NAND flash memory through the NAND flash controller
- Secure Digital/MultiMediaCard (SD/MMC) flash memory through the SD/MMC flash controller
- Serial peripheral interface (SPI) and quad SPI flash memory through the quad SPI flash controller
- FPGA fabric

The HPS boot supports indirect or direct execution of the preloader depending on the boot device. With indirect execution, the boot ROM code copies the preloader from the boot device into the on-chip RAM and jumps to it. Indirect execution is used for flash memory boot sources. With direct execution, the boot ROM code executes the preloader directly from the boot device or from the FPGA fabric boot source.

Configuration of the FPGA portion of the device starts when the FPGA portion is released from the reset state (for example, on power-on). The control block (CB) in the FPGA portion of the device is responsible for obtaining an FPGA configuration image and configuring the FPGA. The FPGA configuration ends when the configuration image has been fully loaded and the FPGA enters user mode. The FPGA configuration image is provided by users and is typically stored in non-volatile flash-based memory. The FPGA CB can obtain a configuration image from the HPS through the FPGA manager or from any of the sources supported by the Cyclone® V FPGAs family.



For more information about the memory and peripheral modules used during the booting and configuration process, refer to their respective chapters:

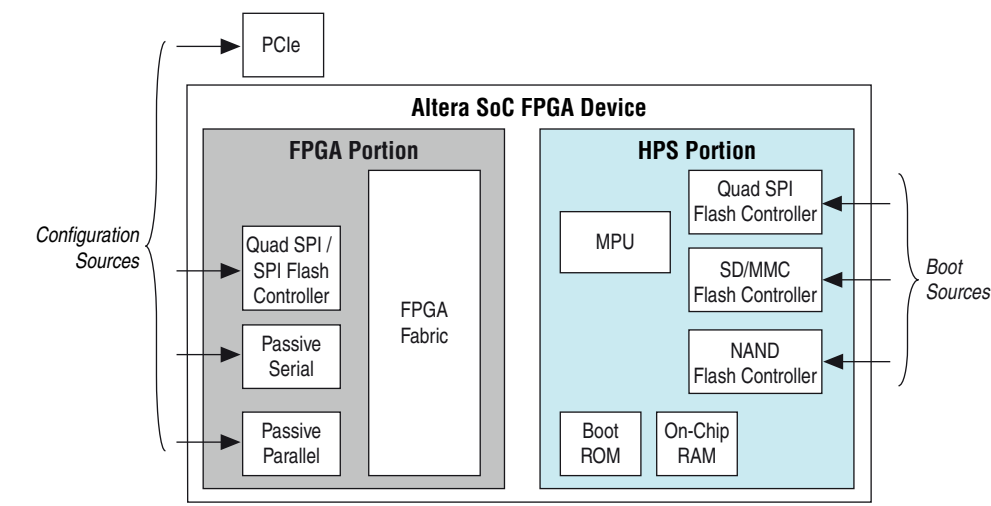
- *On-Chip Memory* chapter in volume 3 of the *Cyclone V Device Handbook*.
- *FPGA Manager* chapter in volume 3 of the *Cyclone V Device Handbook*.

The following three figures illustrate the possible HPS boot and FPGA configuration schemes. The arrows in the figures denote the data flow direction.

■ Independent

Figure A-1 shows that the FPGA configuration and HPS boot occur independently. The FPGA configuration obtains its configuration image from a non-HPS source, while the HPS boot obtains its preloader from a non-FPGA fabric source.

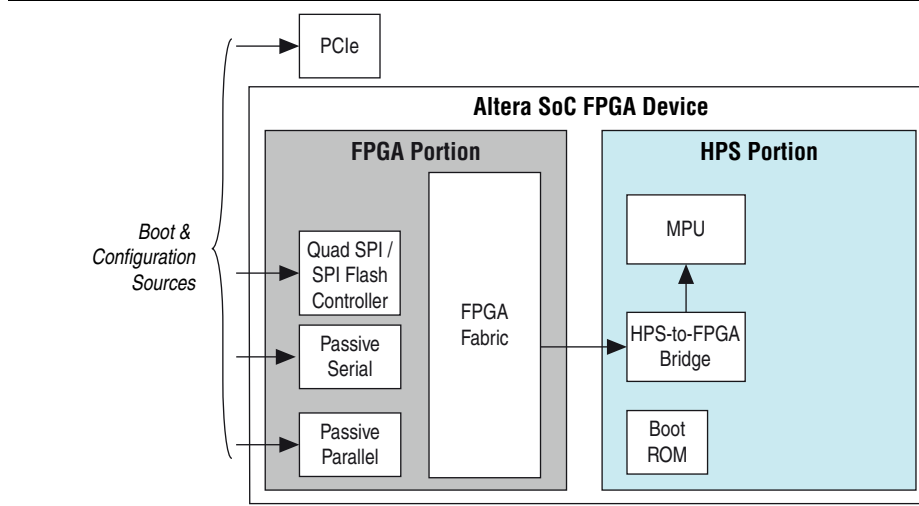
Figure A-1. Independent FPGA Configuration and HPS Booting



■ FPGA first

Figure A-2 shows that the FPGA is first configured through one of its non-HPS configuration sources and then the HPS boots from the FPGA fabric. The HPS boot waits for the FPGA fabric to be powered on and in user mode before executing. The HPS boot ROM code executes the preloader from the FPGA fabric over the HPS-to-FPGA bridge. The preloader can be obtained from the FPGA RAM or by accessing an external interface, depending on your design and implementation.

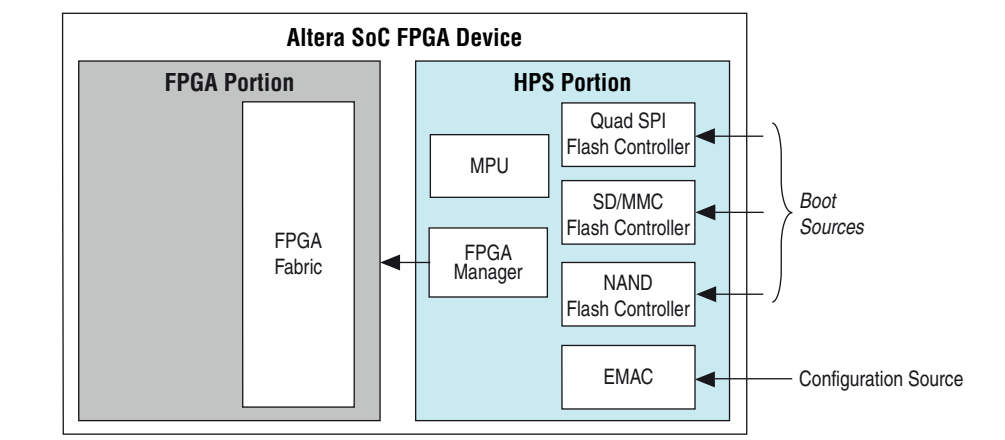
Figure A-2. FPGA Configures First



■ HPS first

Figure A-3 shows that the HPS boots first through one of its non-FPGA fabric boot sources and then software running on the HPS configures the FPGA fabric through the HPS FPGA manager. The software on the HPS obtains the FPGA configuration image from any of its flash memory devices or communication interfaces, for example, the Ethernet media access controller (EMAC). The software is provided by users and the boot ROM is not involved in configuring the FPGA fabric.

Figure A-3. HPS Boots First



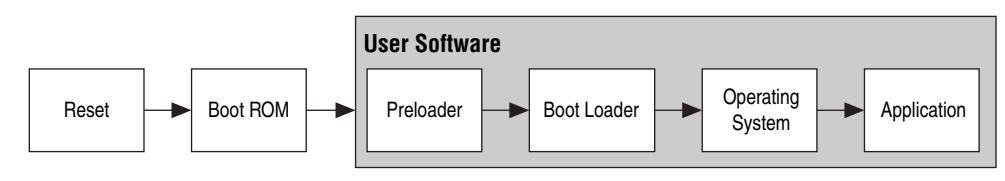
HPS Boot

Booting software on the HPS is a multi-stage process. Each stage is responsible for loading the next stage. The first software stage is the boot ROM. The boot ROM code locates and executes the second stage software, called the preloader. The preloader locates, and if present, executes the next stage software. The preloader and subsequent boot stages (if present) are collectively referred to as user software.

Only the boot ROM code is located in the HPS. The user software is located external to the HPS and is provided by users. The boot ROM code is only aware of the preloader and not aware of any potential subsequent boot stages.

Figure A-4 illustrates the typical boot flow. There may be more or less boot stages in the user software than shown and the roles of the boot stages may vary.

Figure A-4. Typical Boot Flow



Boot Process Overview

Reset

The boot process begins when a CPU in the MPU exits from the reset state. When a CPU exits from reset, it starts running code at the reset exception address. In normal operation, the boot ROM is mapped at the reset exception address so code starts running in the boot ROM.

It is possible to map the on-chip RAM or SDRAM at the reset exception address and run code other than the boot ROM code. However, this chapter assumes that the boot ROM maps to the reset exception address.

Boot ROM

The boot ROM contains software code that executes after a reset exits. The boot ROM code determines if it is running on CPU0 or CPU1. If running on CPU1, the boot ROM code jumps to the value in the CPU1 start address register (`cpu1startaddr`) in the boot ROM code register group (`romcodegrp`) in the system manager. If running on CPU0, the boot ROM code reads the boot select (BSEL) and clock select (CSEL) values from the `bssel` and `csel` fields of the boot information register (`bootinfo`) in the system manager to determine the boot source and to set up the clock manager. The `bssel` and `csel` field values come from the BSEL and CSEL pins. The system manager samples the values on these pins when coming out of a reset.

Table A-1 lists the `bssel` field values for each flash memory device selection.

Table A-1. bssel Field Values and Flash Device Selection

bssel Field Value	Flash Device
0x0	Reserved
0x1	FPGA (HPS-to-FPGA bridge)
0x2	1.8 V NAND flash memory
0x3	3.0 V NAND flash memory
0x4	1.8 V SD/MMC flash memory with external transceiver
0x5	3.0 V SD/MMC flash memory with internal transceiver
0x6	1.8 V SPI or quad SPI flash memory
0x7	3.0 V SPI or quad SPI flash memory

For indirect execution from flash memory boot sources, the boot ROM code loads the preloader image from the flash device to the on-chip RAM and passes software control to the preloader in the on-chip RAM. For direct execution from the FPGA fabric boot source, the boot ROM code waits until the FPGA portion of the device is in user mode and then passes software control to the preloader in the FPGA RAM.

Preloader

The function of the preloader is user-defined. However, typical functions include initializing the SDRAM interface and configuring the HPS I/O pins. Initializing the SDRAM allows the preloader to load the next stage of the boot software (that might not fit in the 60 kilobytes (KB) available in the on-chip RAM). A typical next software stage is the open source boot loader, U-boot.

The preloader is allowed to load the next stage boot software from any device available to the HPS. Typical sources include the same flash device that contains the preloader, a different flash device, or a communication interface such as an EMAC.

Boot Loader

The boot loader loads the operating system and passes software control to the operating system.

Boot ROM

The function of the boot ROM code is to determine the boot source, initialize the HPS after a reset, and jump to the preloader. In the case of indirect execution, the boot ROM code loads the preloader image from the flash memory to on-chip RAM. The boot ROM performs the following actions to initialize the HPS:

Enable instruction cache, branch predictor, floating point unit, NEON vector unit

- Sets up the level 4 (l4) watchdog 0 timer
- Configures the main PLL and peripheral PLL based on the CSEL value
- Configures I/O elements and pin multiplexing based on the BSEL value
- Initializes the flash controller to default settings

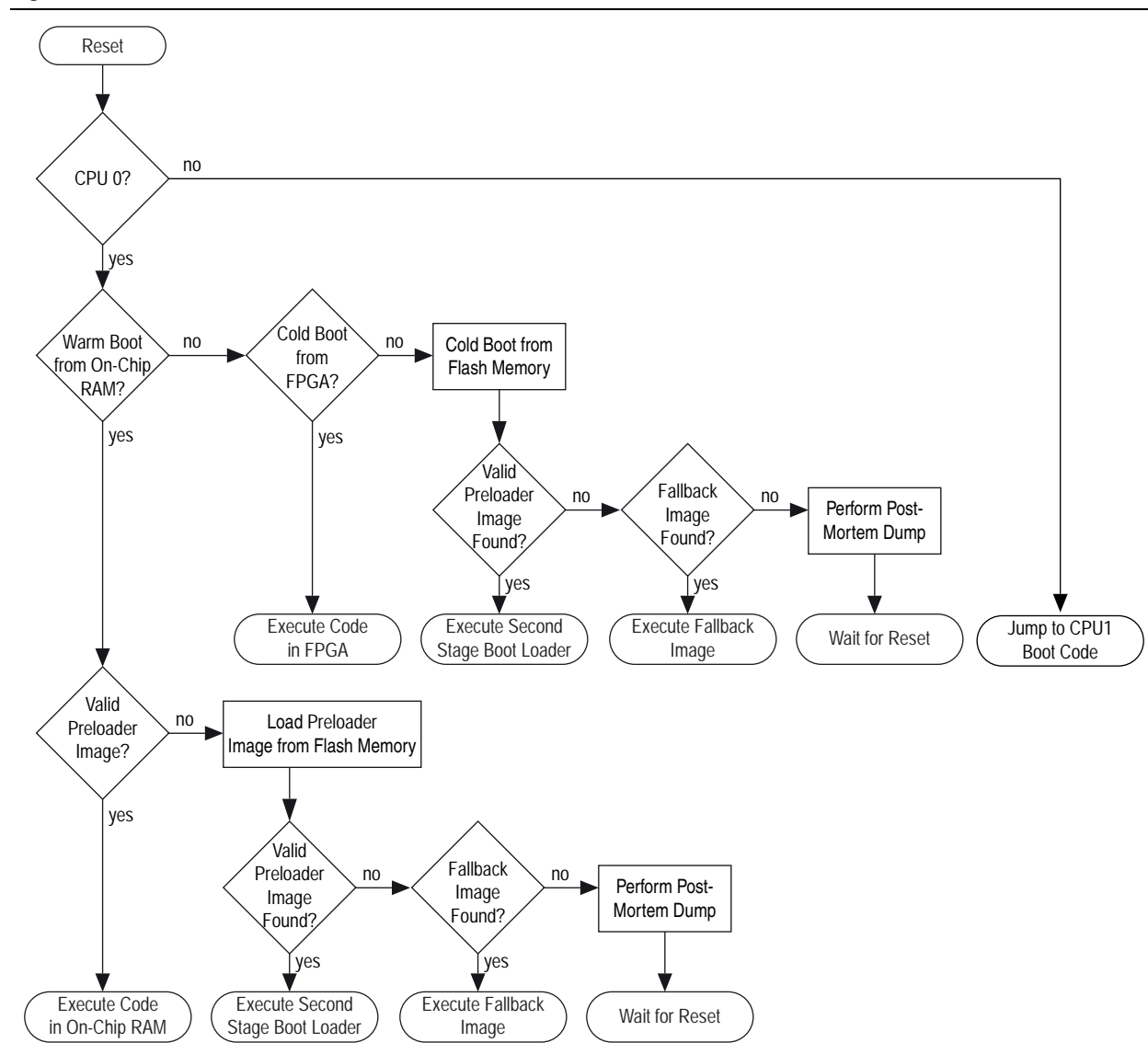
While executing, the boot ROM code uses the top 4 KB of the on-chip RAM as data workspace. This area is reserved for the boot ROM code after a reset until the boot ROM code passes software control to preloader. This limits the maximum size of the preloader for indirect execution to 60 KB.

Boot ROM Flow

This section describes the software flow from reset until the boot ROM code passes software control to the preloader.

Figure A-5 illustrates the boot ROM flow. The boot ROM code can perform a warm boot from on-chip RAM, a cold boot from the FPGA portion of the device, or a cold boot from flash memory.

Figure A-5. Boot ROM Flow



During a cold boot from the FPGA portion of the device, the boot ROM code waits until the FPGA is ready and then attempts direct execution at address 0x0 across the HPS-to-FPGA bridge. For example, the boot software could be provided by initialized on-chip RAM in the FPGA portion of the device at address 0x0. During a cold boot from flash memory, the boot ROM code attempts to load the first preloader image from flash memory to on-chip RAM and pass control to the preloader. If the image is invalid, the boot ROM code attempts to load up to three subsequent images from flash memory. If there is still no valid image found after the subsequent loads, the boot ROM code checks the FPGA portion of the device for a fallback image.

During a warm boot from on-chip RAM, the boot ROM code reads the preloader state register (`initswstate`) in the `romcodegrp` group in the system manager to determine if there is a valid preloader image in the on-chip RAM. If a valid preloader image is found in the on-chip RAM, the boot ROM code skips loading a preloader image from flash memory and instead passes control to the preloader residing in the on-chip RAM.

If a valid preloader image cannot be found in the on-chip RAM, boot ROM code attempts to load the last valid preloader image loaded from the flash memory, identified by the `index` field of the initial software last image loaded register (`initswlastld`) in the `romcodegrp` group in the system manager. If the image is invalid, boot ROM code attempts to load up to three subsequent images from flash memory. If a valid preloader image cannot be found in the on-chip RAM or flash memory, the boot ROM code checks the FPGA portion of the device for a fallback image.

Loading the Preloader

For indirect execution, the boot ROM code loads the preloader image from flash memory into the on-chip RAM and passes control to the preloader. The boot ROM code checks for a valid image by verifying the header and cyclic redundancy check (CRC) in the preloader image. [Figure A-6](#) shows the preloader header.

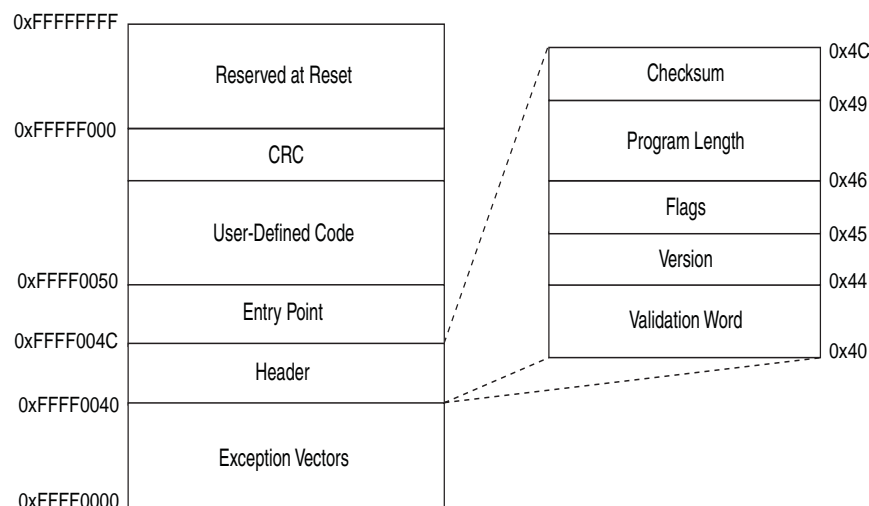
The boot ROM code checks the header for the following information:

- Validation word—validates the preloader image. The validation word has a fixed value of 0x31305341.
- Version—indicates the preloader version.
- Flags—unused
- Program length—the total length of the image (in bytes) from offset 0x0 to the end of code area, including exception vectors and CRC.
- Checksum—a checksum of all the bytes in the header, from offset 0x40 to 0x49.

The preloader image has a maximum size of 60 KB. This size is limited by the on-chip RAM size of 64 KB, where 4 KB is reserved as a workspace for the boot ROM data and stack. The preloader can use this 4 KB region (for its stack and data, for example) after the boot ROM code passes control to the preloader. This 4 KB region is overwritten by the boot ROM code on a subsequent reset.

Figure A-6 shows the preloader image layout in the on-chip RAM after being loaded from the boot ROM.

Figure A-6. Preloader Image Layout ⁽¹⁾



Note to Figure A-6:

(1) Addresses are not represented to scale.

Exception vectors—Exception vectors are located at the start of the on-chip RAM. Typically, the preloader remaps the lowest region of the memory map to the on-chip RAM (from the boot ROM) to create easier access to the exception vectors.

Header—contains information such as validation word, version, flags, program length, and checksum for the boot ROM code to validate the preloader image before passing control to the preloader.

Entry point—contains the preloader image address. After the boot ROM code validates the header, the boot ROM code jumps to this address.

User-defined code—typically contains the program code of the preloader.

CRC—contains a CRC of data from address 0xFFFF0000 to 0xFFFF0000+(*Program Length**4)–0x0004. The polynomial used to validate the preloader image is $x^{32} + x^{26} + x^{23} + x^{22} + x^{16} + x^{12} + x^{11} + x^{10} + x^8 + x^7 + x^5 + x^4 + x^2 + x + 1$. There is no reflection of the bits. The initial value of the remainder is 0xFFFFFFFF and the final value is XORed with 0xFFFFFFFF.

Reserved at reset—the top 4 KB is reserved for the boot ROM code after a reset. The boot ROM code uses this area for internal structures, workspace, and post-mortem dump. This area includes the shared memory where the boot ROM code passes information to the preloader.

Shared Memory

The shared memory contains information that the boot ROM code passes to the preloader. The boot ROM code passes the location of shared memory to the preloader in register r0, as described in “HPS State on Entry to the Preloader” on page A-10.

The shared memory contains the following information:

- Common—contains non-flash-specific settings used by the boot ROM code.
- Saved hardware register—contains hardware register values that the boot ROM code saves before the registers are modified by the boot ROM code.
- Flash device-specific—contains flash device-specific settings used by the boot ROM code that the preloader may use to continue using the flash device without reinitialization.

Table A-2 lists the contents of the shared memory block.

Table A-2. Shared Memory Block (Part 1 of 2)

Information Type	Content	Description
Common	Flash image	Indicates which preloader image (0-3) the boot ROM code loaded from the flash device. A nonzero value indicates that there was an error loading image 0 and the boot ROM code loaded another image.
	CSEL value used	Indicates the CSEL value used by the boot ROM code. Typically, this value is the value read from the <code>csel</code> field of the <code>bootinfo</code> register in the <code>romcodegrp</code> group in the system manager. However, if the PLL fails to lock, the boot ROM code ignores the <code>csel</code> field and uses zero to indicate PLL bypass mode.
	BSEL value used	Indicates the BSEL value used by the boot ROM code. Typically, this value is the value read from the <code>bsel</code> field of the <code>bootinfo</code> register in the <code>romcodegrp</code> group in the system manager.
	Last page	Indicates the address of the last page read from the flash device.
	Page size	Indicates the page size used by the flash device. <ul style="list-style-type: none"> ■ For NAND flash memory, the boot ROM code reads this value from the NAND flash controller. ■ For SPI and quad SPI flash memory, the boot ROM code configures the page size through the quad SPI flash controller. ■ For SD/MMC flash memory, the boot ROM code configures the page size through the SD/MMC flash controller.
	Flash device type	Indicates the flash device used by the boot ROM code.
	Step complete	Track the completion state of up to 64 individual major steps during the boot process. The 64 bit value has one bit set for each major step completed in the boot process.
Saved hardware registers	CPU0 and CPU1 crash data	Indicates the CPU0 and CPU1 crash data. These values are pointers to where the boot ROM code saves the crash dump in an event of a crash.
	Status register (<code>stat</code>) of the reset manager	Contains reset source and event timeout information.
	Control (<code>ctrl</code>) register in the <code>romcodegrp</code> group in the system manager	Contains information used to control the boot ROM code.
	<code>initstate</code> register in the <code>romcodegrp</code> group in the system manager	Contains the magic value 0x49535756 when the preloader has reached a valid state.

Table A-2. Shared Memory Block (Part 2 of 2)

Information Type	Content	Description
Flash device-specific (SD/MMC)	is_sd_card	Indicates the card type. 1 indicates SD card; 0 indicates MMC.
	is_sector_mode	Indicates the addressing mode of card. 1 indicates sector addressing mode; 0 indicates byte addressing mode.
	rca	Contains the relative card address, which is used for host-card communication during card identification
	partition_start_sector	Indicates the partition start offset in unit sectors. 0 indicates raw mode.
	partition_size	Size of the partition in unit sectors. 0 indicates raw mode.

L4 Watchdog 0 Timer

The L4 watchdog 0 timer is reserved for boot ROM use. If a watchdog reset happens before software control passes to the preloader, boot ROM code attempts to load the last valid preloader image, identified by the `initswlastld` register in the `romcodegrp` group in the system manager.

HPS State on Entry to the Preloader

When the boot ROM code is ready to pass control to the preloader, the processor (CPU0) is in the following state:

- Instruction cache is enabled
- Branch predictor is enabled
- Data cache is disabled
- MMU is disabled
- Floating point unit is enabled
- NEON vector unit enabled
- Processor is in ARM secure supervisor mode

The boot ROM code sets the ARM® Cortex™-A9 MPCore™ registers to the following values:

- `r0`—contains the pointer to the shared memory block, which is used to pass information from the boot ROM code to the preloader. The shared memory block is located in the top 4 KB of on-chip RAM.
- `r1`—contains the length of the shared memory.
- `r3`—unused and set to 0x0.
- `r4`—unused and set to 0x0.

All other MPCore registers are undefined.



When booting CPU0 using the FPGA boot, or when booting CPU1 using any boot source, all MPCore registers, caches, the MMU, the floating point unit, and the NEON vector unit are undefined. HPS subsystems and the PLLs are undefined.

When the boot ROM code passes control to the preloader, the following conditions also exist:

- The boot ROM is still mapped to address 0x0.
- The L4 watchdog 0 timer is active.

Preloader

The preloader typically performs the following actions:

- Initialize the SDRAM interface.
- Configure the remap register of the L3 (NIC-301) GPV registers (13regs) to map the on-chip RAM to address 0x0 so that exceptions are handled by the preloader.



The on-chip RAM is also accessible at address 0xFFFF0000. The address 0x0 is an alias.

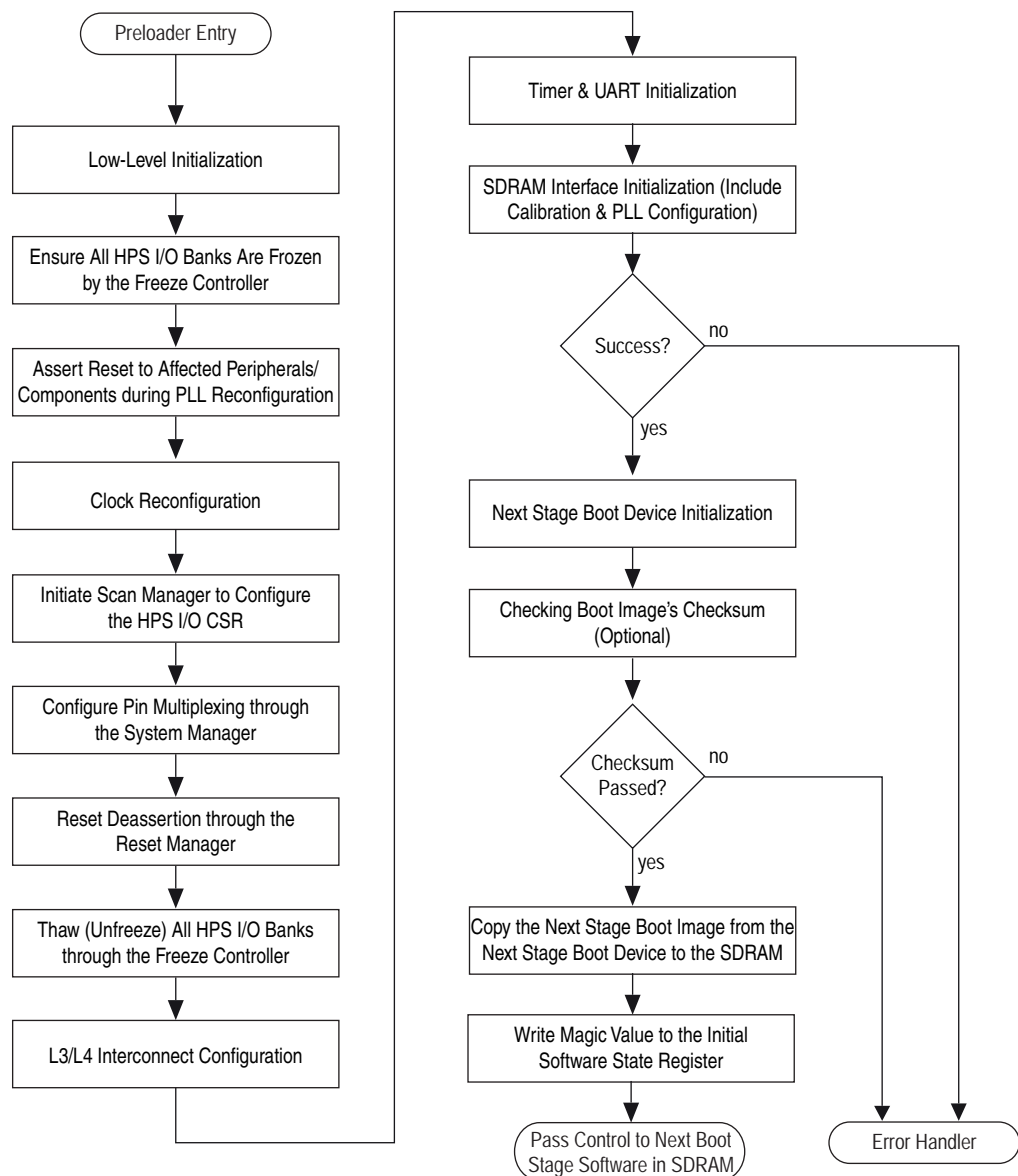
- Configure the HPS I/O through the scan manager.
- Configure pin multiplexing through the system manager.
- Configure HPS clocks through the clock manager.
- Initialize the flash controller (NAND, SD/MMC, or quad SPI) that contains the next stage boot software.
- Load the next stage boot software into the SDRAM and pass control to it.

Typical Preloader Boot Flow

This section describes a typical software flow from the preloader entry point until the software passes control to the next stage boot software.

Figure A-7 shows a typical preloader boot flow.

Figure A-7. Typical Preloader Boot Flow



Low-level initialization steps include reconfiguring or disabling the L4 watchdog 0 timer, invalidating the instruction cache and branch predictor, remapping the on-chip RAM to the lowest memory region, and setting up the data area.

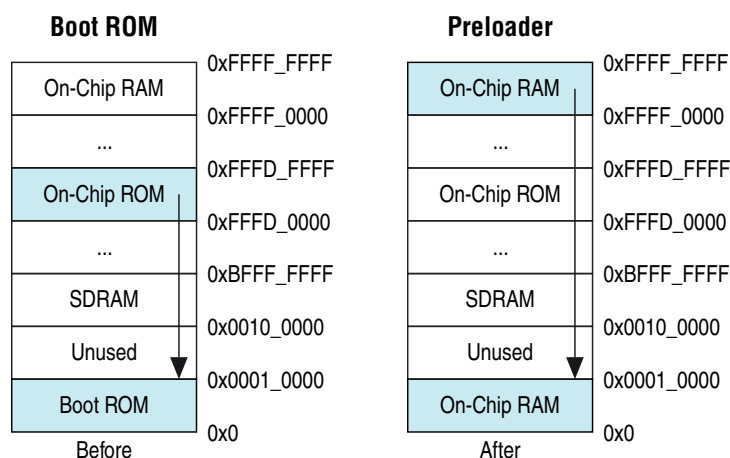
Upon entering the preloader, the L4 watchdog 0 timer is active. The preloader can either disable, reconfigure, or leave the watchdog timer unchanged. Once enabled after reset, the watchdog timer cannot be disabled, only paused.

The instruction cache and branch predictor, which were previously enabled by the boot ROM code, need to be invalidated.

The preloader needs to remap the exception vector table because the exception vectors are still pointing to the exception handler in the boot ROM when the preloader starts executing. By setting the L3 interconnect remap bit 0 to high, the on-chip RAM mirrors to the lowest region of the memory map. After this remap, the exception vectors will use the exception handlers in the preloader image.

Figure A-8 shows the memory map before and after remap.

Figure A-8. Remapping the On-Chip RAM ⁽¹⁾



Note to Figure A-8:

(1) Addresses are not represented to scale.

The preloader can reconfigure all HPS clocks. During clock reconfiguration, the preloader asserts reset to the peripherals in the HPS affected by the clock changes.

The preloader configures HPS I/O pins through the scan manager and pin multiplexing through the system manager. The preloader initiates the freeze controller in the scan manager to freeze all the I/O pins and put them in a safe state during I/O configuration and pin multiplexing.

The SDRAM goes through full initialization for cold boot or a partial initialization for warm boot. For full initialization, the preloader configures the SDRAM PLL before releasing the SDRAM interface from reset. SDRAM calibration adjusts I/O delays and FIFO settings to compensate for any board skew or impairment in the board, FPGA portion of the device, or memory device. For partial initialization, SDRAM PLL configuration and SDRAM calibration is not necessary.

The preloader looks for a valid next stage boot image in the next stage boot device by checking the boot image validation data and checksum in the mirror image. Once validated, the preloader copies the next stage boot image from the next stage boot device to the SDRAM.

Before software passes control to the next stage boot software, the preloader can write a valid value (such as 0x49535756) to the preloader `initswstate` register under the `romcodegrp` group in the system manager. This value indicates that there is a valid boot image in the on-chip RAM. When a warm reset occurs, the boot ROM code can check the `initswstate` register for the magic value to determine if it needs to reload the preloader image into the on-chip RAM.

Flash Memory Devices

The flash memory devices available for HPS boot are the NAND, SD/MMC, SPI, and quad SPI. The flash device can store the following kinds of files for booting purposes:

- Preloader binary file (up to four copies)
- Boot loader binary file
- Operating system binary file
- Application file
- FPGA programming files



The preloader file must be stored in a partition with no file system.

NAND Flash Devices

Figure A-9 shows the NAND flash image layout. The preloader image is located at offsets which are multiples of the block size. If the image size is less than 64 KB, only one block size is used. Since a block is the smallest area used for erase operation, any update to a particular image does not affect other images.

Figure A-9. NAND Flash Image Layout

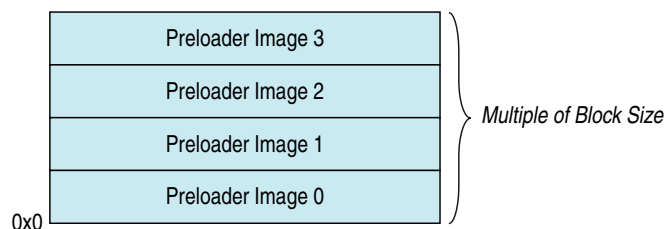


Table A-3 lists the NAND flash driver features supported in the boot ROM code.

Table A-3. NAND Flash Support Features

Feature	Driver Support
Device	Open NAND Flash Interface (ONFI) 1.0 raw NAND or electronic signature devices, single layer cell (SLC) and multiple layer cell (MLC) devices with integrated error correction code (ECC).
Chip select	CS0 only. Only CS0 is available to the HPS, the other three chip selects are routed out to the FPGA portion of the device.
Bus width	x8 only
Page size	512 bytes, 2 KB, 4 KB, or 8 KB.
Page per block	8, 16, 32, or 128
ECC	512-bytes with 8-bit correction

Table A-4 lists the CSEL pin settings for the quad SPI controller.

Table A-4. NAND Controller CSEL Pin Settings

Setting	CSEL Pin			
	0	1	2	3
osc1_clk (EOSC1 pin) range	10–50 MHz	10–12.5 MHz	12.5–25 MHz	25–50 MHz
nand_x_clk /25 device frequency	osc1_clk/25, 2 MHz max	osc1_clk*20/25, 9.6 MHz max	osc1_clk*10/25, 9.6 MHz max	osc1_clk*5/25, 9.6 MHz max
nand_x_clk controller clock	osc1_clk, 50 MHz max	osc1_clk*20, 240 MHz max	osc1_clk*10, 240 MHz max	osc1_clk*5, 240 MHz max
mpu_clk	osc1_clk, 50 MHz max	osc1_clk*32, 400 MHz max	osc1_clk*16, 400 MHz max	osc1_clk*8, 400 MHz max
PLL modes	Bypassed	Locked	Locked	Locked

For more information about the NAND flash memory, refer to the *NAND Flash Controller* chapter in volume 3 of the *Cyclone V Device Handbook*.

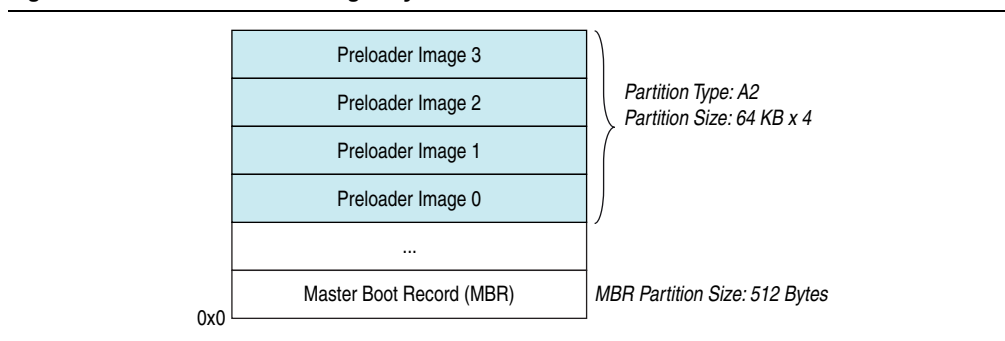
SD/MMC Flash Devices

Figure A-10 shows the SD/MMC flash image layout. The master boot record (MBR) is located at the first 512 bytes of the memory. The MBR contains information of partitions (address and size of partition). The preloader image is always stored in partition A2. Partition A2 is a custom raw partition with no file system.

The start address of each image is based on the following formula:

Start address = start address + ($\langle n \rangle * 64 \text{ K}$), where $\langle n \rangle$ is the image number

Figure A-10. SD/MMC Flash Image Layout



The SD/MMC controller supports two booting modes:

- MBR (partition) mode
 - The boot image is read from a custom partition (0xA2)
 - The first image is located at the beginning of the partition, at offset 0x0
 - Start address = partition start address

- Raw mode
 - If the MBR signature is not found, SD/MMC driver assumes it is in raw mode. The boot image data is read directly from sectors in the user area and is located at the first sector of the SD/MMC.
 - The first image is located at the start of the memory card, at offset 0
 - Start address = 0

MBR

The MBR contains the partition table, which is always located on the first sector (LBA0) with a memory size of 512 bytes. The MBR consists of executable code, four partition entries, and the MBR signature. A MBR can be created by specific tools like the FDISK program.

Table A-5 lists the MBR structure.

Table A-5. MBR Structure

Offset	Size (Byte)	Description
0x000	446	Code area
0x1BE	16	Partition entry for partition 1
0x1CE	16	Partition entry for partition 2
0x1DE	16	Partition entry for partition 3
0x1EE	16	Partition entry for partition 4
0x1FE	2	MBR signature: 0xAA55

The standard MBR structure contains a partition with four 16-bytes entries. Thus, memory cards using this standard table cannot have more than four primary partitions or up to three primary partitions and one extended partition.

Each partition type is defined by the partition entry. The boot images are stored in a primary partition with custom partition type (0xA2). The SD/MMC flash driver does not support file system, so the boot images are located in partition A2 at fixed locations. Table A-6 lists the partition entry.

Table A-6. Partition Entry

Offset	Size (Byte)	Description
0x0	1	Boot indicator. 0x80 indicates that it is bootable.
0x1	3	Starting CHS value
0x4	1	Partition type
0x5	3	Ending CHS value
0x8	4	LBA of first section in partition
0xB	4	Number of sectors in partition

The boot ROM code configures the SD/MMC controller to default settings for the supported SD/MMC flash memory. Table A-7 lists the default settings of the SD/MMC controller.

Table A-7. SD/MMC Controller Default Settings

Parameter		Default	Register Value
Card type		1 bit	The card type register (ctype) in the SD/MMC controller registers (sdmmc) = 0x0
Timeout		Maximum	The timeout register (tmout) = 0xFFFFFFFF
FIFO threshold RX watermark level		1	The RX watermark level field (rx_wmark) of the FIFO threshold watermark register (fifoeth) = 0x1
Clock source		0	The clock source register (clksrc) = 0x0
Block size		512	The block size register (blksiz) = 0x200
Clock divider	Identification mode	32	The clock divider register (clkdiv)= 0x10 (2*16=32)
	Data transfer mode	Bypass	The clock divider register (clkdiv)= 0x00

Table A-8 lists the CSEL pin settings for the SD/MMC controller.

Table A-8. SD/MMC Controller CSEL Pin Settings

Setting		CSEL Pin			
		0	1	2	3
osc1_clk (EOSC1 pin) range		10–50 MHz	10–12.5 MHz	12.5–25 MHz	25–50 MHz
ID mode	sdmmc_cclk_out device clock	osc1_clk/128, 391 KHz max	osc1_clk/32, 391 KHz max	osc1_clk/64, 391 KHz max	osc1_clk/128, 391 KHz max
	Controller baud rate divisor	32	32	32	32
Data transfer mode	sdmmc_cclk_out device clock	osc1_clk/4, 12.5 MHz max	osc1_clk*1, 12.5 MHz max	osc1_clk/2, 12.5 MHz max	osc1_clk/4, 12.5 MHz max
	Controller baud rate divisor (even numbers only)	1 (bypass)	1 (bypass)	1 (bypass)	1 (bypass)
sdmmc_clk controller clock:		osc1_clk, 50 MHz max	osc1_clk, 50 MHz max	osc1_clk, 50 MHz max	osc1_clk*2, 50 MHz max
mpu_clk		osc1_clk, 50 MHz max	osc1_clk*32, 400 MHz max	osc1_clk*16, 400 MHz max	osc1_clk*8, 400 MHz max
PLL modes		Bypassed	Locked	Locked	Locked

 For more information about the SD/MMC, refer to the *SD/MMC Controller* chapter in volume 3 of the *Cyclone V Device Handbook*.

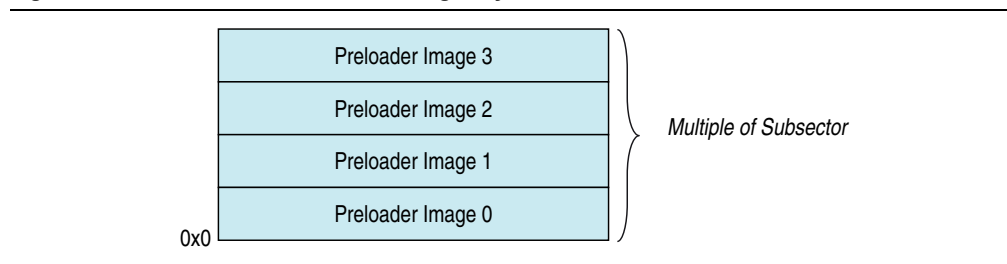
SPI and Quad SPI Flash Devices

Figure A-11 shows the SPI and quad SPI flash image layout. The preloader image is always located at offsets which are multiples of a subsector size. If the image is less than 64 KB, only one subsector is used. If subsector erase is not supported, sector erase is supported. Since a subsector is the smallest area used for erase operation, any update to a particular image does not affect other images.

The first image is located at offset 0 and followed by subsequent images. The start address of each image is based on the following formula:

Start address = (N * 64K), where N is the image number

Figure A-11. SPI and Quad SPI Flash Image Layout



The boot ROM code configures the quad SPI controller to default settings for the supported SPI or quad SPI flash memory. [Table A-9](#) lists the default settings of the quad SPI controller.

Table A-9. Quad SPI Controller Default Settings

Parameter	Default Setting	Register Value
SPI baud rate.	Divide by 4	The master mode baud rate divisor field (<i>bauddiv</i>) of the quad SPI configuration register (<i>cfg</i>) in the quad SPI controller registers (<i>qspi_regs</i>) = 1.
Read opcode.	Normal read	The read opcode in non-XIP mode field (<i>rdopcode</i>) in the device read instruction register (<i>devrd</i>) = 0x3.
Instruction type.	Single I/O (1 bit wide)	The address transfer width field (<i>addrwidth</i>) and data transfer width field (<i>datawidth</i>) of the <i>devrd</i> register = 0.
Delay in master reference clocks for the length that the master mode chip select outputs are deasserted between words when the clock phase is zero.	200 ns	The clock delay for chip select deassert field (<i>nss</i>) in the quad SPI device delay register (<i>delay</i>). Refer to <i>delay</i> [31:24] in Table A-11 on page A-19 .
Delay in master reference clocks between one chip select being deactivated and the activation of another. This delay ensures a quiet period between the selection of two different slaves and requires the transmit FIFO to be empty.	0 ns	The clock delay for chip select deactivation field (<i>btwn</i>) in the <i>delay</i> register = 0x0.
Delay in master reference clocks between the last bit of the current transaction and the first bit of the next transaction. If the clock phase is zero, the first bit of the next transaction refers to the cycle in which the chip select is deselected.	20 ns	The clock delay for last transaction bit field (<i>after</i>) in the <i>delay</i> register. Refer to <i>delay</i> [15:8] in Table A-11 on page A-19 .
Added delay in master reference clocks between setting <i>qspi_n_ss_out</i> low and first bit transfer.	20 ns	The clock delay with <i>qspi_n_ss_out</i> field (<i>init</i>) in the <i>delay</i> register. Refer to <i>delay</i> [7:0] in Table A-11 on page A-19 .
Number of address bytes.	3 bytes	The number of address bytes field (<i>numaddrbytes</i>) of the device size register (<i>devsz</i>) = 2.

Table A-10 lists the CSEL pin settings for the quad SPI controller.

Table A-10. Quad SPI Controller CSEL Pin Settings

Setting	CSEL Pin			
	0	1	2	3
oscl_clk (EOSC1 pin) range	10–50 MHz	20–50 MHz	25–50 MHz	10–25 MHz
sclk_out device clock	oscl_clk/4, 12.5 MHz max	oscl_clk/2, 25 MHz max	oscl_clk*1, 50 MHz max	oscl_clk*2, 50 MHz max
qspi_clk controller clock	oscl_clk, 50 MHz max	oscl_clk*2, 100 MHz max	oscl_clk*4, 200 MHz max	oscl_clk*8, 200 MHz max
Controller baud rate divisor (even numbers only)	4	4	4	4
Flash read instruction (1 dummy byte for READ_FAST)	READ	READ	READ_FAST	READ_FAST
mpu_clk	oscl_clk, 50 MHz max	oscl_clk*8, 400 MHz max	oscl_clk*8, 400 MHz max	oscl_clk*16, 400 MHz max
PLL modes	Bypassed	Locked	Locked	Locked

The delay register in the quad SPI controller registers (qspiregs) configures relative delay into the generation of the master output signals.

The SPI or quad SPI flash memory needs to meet the following timing requirements:

- T_{SLCH} (delay[7:0]): 20 ns
- T_{CHSH} (delay[15:8]): 20 ns
- T_{SHSL} (delay[31:24]): 200 ns

Table A-11 lists the delay register configuration with CSEL pin settings.

Table A-11. SPI and Quad SPI Flash Delay Configuration

CSEL Pin	T_{ref_clk} (ns)	T_{sclk_out} (ns)	Device Delay Register		
			delay[7:0]	delay[15:8]	delay[31:24]
0	20	80	0	0	6
1	10	40	0	0	16
2–3	5	20	0	0	36



The formula to calculate the delay is $(T_{delay} - T_{sclk_out}) / T_{ref_clk}$.



For more information about the quad SPI flash memory, refer to the *Quad SPI Flash Controller* chapter in volume 3 of the *Cyclone V Device Handbook*.

FPGA Configuration

You can configure the FPGA portion of the SoC device with non-HPS sources or by utilizing the HPS. Software executing on the HPS configures the FPGA by writing the configuration image to the FPGA manager in the HPS. Software can control the configuration process and monitor the FPGA status by accessing the control and status register (CSR) interface in the FPGA manager.

-  For more information about configuring the FPGA through the HPS FPGA manager, refer to the *FPGA Manager* chapter in volume 3 of the *Cyclone V Device Handbook*.
-  For more information about configuring the FPGA in general, refer to the *Configuration, Design Security, and Remote System Upgrades in Cyclone V Devices* chapter in volume 1 of the *Cyclone V Device Handbook*.

Full Configuration

The HPS uses the FPGA manager to configure the FPGA portion of the device. The following sequence suggests one way for software to perform a full configuration:

1. Set the `cdratio` and `cfgwidth` bits of the `ctrl` register in the FPGA manager registers (`fpgamgrregs`) to match the characteristics of the configuration image. These settings are dependant on the MSEL pins input.
2. Set the `nce` bit of the `ctrl` register to 0 to enable HPS configuration.
3. Set the `en` bit of the `ctrl` register to 1 to give the FPGA manager control of the configuration input signals.
4. Set the `nconfigpull` bit of the `ctrl` register to 1 to pull down the `nCONFIG` pin and put the FPGA portion of the device into the reset phase.
5. Poll the `mode` bit of the `stat` register and wait until the FPGA enters the reset phase.
6. Set the `nconfigpull` bit of the `ctrl` register to 0 to release the FPGA from reset.
7. Read the `mode` bit of the `stat` register and wait until the FPGA enters the configuration phase.
8. Clear the state of the `nSTATUS` bits (`ns`) in the configuration monitor registers (`fpgamgrregs.mon`).
9. Set the `axicfggen` bit of the `ctrl` register to 1 to enable sending configuration data to the FPGA.
10. Write the configuration image to the configuration data register (`data`) in the FPGA manager module configuration data registers (`fpgamgrdata`). You can also choose to use a DMA controller to transfer the configuration image from a peripheral device to the FPGA manager.
11. Use the `fpgamgrregs.mon` registers to monitor the `CONF_DONE` (`cd`) and `nSTATUS` (`ns`) bits.
 - a. `CONF_DONE = 1` and `nSTATUS = 1` indicates successful configuration.
 - b. `CONF_DONE = 0` or `nSTATUS = 0` indicates unsuccessful configuration. Complete steps 12 and 13, then go back and repeat steps 3 to 10 to reload the configuration image.
12. Set the `axicfggen` bit of the `ctrl` register to 0 to disable configuration data on AXI slave.
13. Send the DCLKs required by the FPGA to enter the initialization phase.
 - a. If DCLK is unused, write a value of 4 to the DCLK count register (`dclkcnt`).
 - b. If DCLK is used, write a value of 20,480 (0x5000) to the `dclkcnt` register.

14. Poll the `dcntdone` bit of the DCLK status register (`dclkstat`) until it changes to 1, which indicates that all the DCLKs have been sent.
15. Write a 1 to the `dcntdone` bit of the DCLK status register to clear the completed status flag.
16. Read the `mode` bit of the `stat` register to wait for the FPGA to enter user mode.
17. Set the `en` bit of the `ctrl` register to 0 to allow the external pins to drive the configuration input signals.

If the HPS resets in the middle of a normal configuration data transfer before entering user mode, software can assume that the configuration is unsuccessful. After the HPS resets, software must repeat the steps for full configuration.

Partial Reconfiguration

Partial reconfiguration allows you to reconfigure part of the device while other sections remain running. The HPS performs partial reconfiguration while the FPGA portion of the device is in user mode. The following sequence suggests one way for software to perform a partial configuration:

1. Read the `mode` bit of the `stat` register in `fpgamgrregs` to ensure that the FPGA is in user mode.
2. Set the `cdratio` bit of the `ctrl` register to match the characteristics of the partial reconfiguration image and set the `cfgwidth` bit of the `ctrl` register to 0 for 16-bit configuration data width.
3. Set the `en` bit of the `ctrl` register to 1 to give the FPGA manager control of the configuration input signals.
4. Set the `prreq` bit of the `ctrl` register to 1 to assert `PR_REQUEST`.
5. Write a value of 1 to the `dclkcnt` register to generate DCLK pulses for one clock cycle.
6. Poll the `fpgamgrregs.mon` registers to observe the `PR_READY` (`prr`) bit.
 - a. If `PR_READY=1`, continue to step 7.
 - b. If `PR_READY` is 0, then go back and repeat step 5. Note that a minimum of 16 DCLK pulses are required.
7. Write a value of 3 to the `dclkcnt` register to generate DCLK pulses for three clock cycles.
8. Set the `axicfggen` bit of the `ctrl` register to 1 to enable sending configuration data to the FPGA.
9. Write the partial reconfiguration image to the data register in the FPGA manager `fpgamgrdata` registers. You can also choose to use a DMA to transfer the configuration image from a peripheral device to the FPGA manager.

10. Poll the `fpgamgrregs.mon` registers to observe the `PR_DONE` (`prd`), `PR_READY` (`prp`), `PR_ERROR` (`pre`), and `CRC_ERROR` (`crc`) bits until the bits match one of the completion statuses shown in [Table A-12](#).

Table A-12. Partial Reconfiguration Status

Bits				Partial Reconfiguration Status
PR_DONE	PR_READY	PR_ERROR	CRC_ERROR	
1	0	0	0	Completed
0	0	1	0	Completed with error
0	0	0	1	Completed with a SEU event CRC error

11. Set the `axicfgn` bit of the `ctrl` register to 0 to disable sending configuration data to the FPGA.
12. Set the `prreq` bit of the `ctrl` register to 0 to deassert `PR_REQUEST`.
13. Write a value of 128 to the `dclkcnt` register to generate DCLK pulses for 128 clock cycles.
14. Poll the `dcntdone` bit of the `dclkstat` register until it changes to 1, which indicates that all the DCLKs have been sent.
15. Write a 1 to the `dcntdone` bit of the `dclkstat` register to clear the completed status flag.
16. Poll the `fpgamgrregs.mon` registers to observe the `PR_DONE` (`prd`), `PR_READY` (`prp`), `PR_ERROR` (`pre`), and `CRC_ERROR` (`crc`) bits. When all bits are set to 0, the FPGA is ready for the next transaction.
17. Set the `en` bit of the `ctrl` register to 0 to allow the external pins to drive the configuration input signals.

If the HPS resets in the middle of a partial reconfiguration, software can assume that the configuration is unsuccessful. After an HPS warm reset, software must repeat the steps for partial configuration. After an HPS cold reset, software must repeat the steps for [“Full Configuration”](#) on page A-20.



For more information about the configuration modes and pin settings, refer to the [FPGA Manager](#) chapter in volume 3 of the *Cyclone V Device Handbook*.

Document Revision History

[Table A-13](#) shows the revision history for this document.

Table A-13. Document Revision History (Part 1 of 2)

Date	Version	Changes
November 2012	1.3	<ul style="list-style-type: none"> Expanded shared memory block table. Added CSEL tables. Additional minor updates.
June 2012	1.2	Updated the HPS boot and FPGA configuration sections.

Table A-13. Document Revision History (Part 2 of 2)

Date	Version	Changes
May 2012	1.1	<ul style="list-style-type: none">■ Updated the HPS boot section.■ Added information about the flash devices used for HPS boot.■ Added information about the FPGA configuration mode.
January 2012	1.0	Initial release.

This chapter provides additional information about the document and Altera.

How to Contact Altera

To locate the most up-to-date information about Altera products, refer to the following table.

Contact ⁽¹⁾	Contact Method	Address
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Nontechnical support (general) (software licensing)	Email	nacomp@altera.com
	Email	authorization@altera.com










Note to Table:

(1) You can also contact your local Altera sales office or sales representative.

Typographic Conventions

The following table shows the typographic conventions this document uses.

Visual Cue	Meaning
Bold Type with Initial Capital Letters	Indicate command names, dialog box titles, dialog box options, and other GUI labels. For example, Save As dialog box. For GUI elements, capitalization matches the GUI.
bold type	Indicates directory names, project names, disk drive names, file names, file name extensions, software utility names, and GUI labels. For example, \qdesigns directory, D: drive, and chiptrip.gdf file.
<i>Italic Type with Initial Capital Letters</i>	Indicate document titles. For example, <i>Stratix IV Design Guidelines</i> .
<i>italic type</i>	Indicates variables. For example, $n + 1$. Variable names are enclosed in angle brackets (< >). For example, <file name> and <project name>.pof file.
Initial Capital Letters	Indicate keyboard keys and menu names. For example, the Delete key and the Options menu.
"Subheading Title"	Quotation marks indicate references to sections in a document and titles of Quartus II Help topics. For example, "Typographic Conventions."

Visual Cue	Meaning
Courier type	<p>Indicates signal, port, register, bit, block, and primitive names. For example, <code>data1</code>, <code>tdi</code>, and <code>input</code>. The suffix <code>n</code> denotes an active-low signal. For example, <code>resetn</code>.</p> <p>Indicates command line commands and anything that must be typed exactly as it appears. For example, <code>c:\qdesigns\tutorial\chiptrip.gdf</code>.</p> <p>Also indicates sections of an actual file, such as a Report File, references to parts of files (for example, the AHDL keyword <code>SUBDESIGN</code>), and logic function names (for example, <code>TRI</code>).</p>
	An angled arrow instructs you to press the Enter key.
1., 2., 3., and a., b., c., and so on	Numbered steps indicate a list of items when the sequence of the items is important, such as the steps listed in a procedure.
	Bullets indicate a list of items when the sequence of the items is not important.
	The hand points to information that requires special attention.
	The question mark directs you to a software help system with related information.
	The feet direct you to another document or website with related information.
	The multimedia icon directs you to a related multimedia presentation.
	A caution calls attention to a condition or possible situation that can damage or destroy the product or your work.
	A warning calls attention to a condition or possible situation that can cause you injury.
	The envelope links to the Email Subscription Management Center page of the Altera website, where you can sign up to receive update notifications for Altera documents.